# **SANDIA REPORT**

SAND2021-13267 Printed October 2021



# **Xyce<sup>™</sup> Parallel Electronic Simulator Reference Guide, Version 7.4**

Eric R. Keiter, Thomas V. Russo, Richard L. Schiek, Heidi K. Thornquist, Ting Mei, Jason C. Verley, Peter E. Sholander, Karthik V. Aadithya, Joshua D. Schickling

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# **ABSTRACT**

This document is a reference guide to the Xyce Parallel Electronic Simulator, and is a companion document to the Xyce Users' Guide [1]. The focus of this document is (to the extent possible) exhaustively list device parameters, solver options, parser options, and other usage details of Xyce. This document is *not* intended to be a tutorial. Users who are new to circuit simulation are better served by the Xyce Users' Guide [1].

# **ACKNOWLEDGMENTS**

We would like to acknowledge all the code and test suite developers who have contributed to the Xyce project over the years: Aaron Gibson, Alan Lundin, Antonio Gonzales, Ashley Meek, Bart van Bloemen Waanders, Brad Bond, Brian Fett, Christina Warrender, David Baur, David Day, David Shirley, Deborah Fixel, Derek Barnes, Eric Rankin, Erik Zeek, Gary Hennigan, Herman "Buddy" Watts, Jim Emery, Jonathan Woodbridge, Jonathen Kwok, Keith Santarelli, Laura Boucheron, Lawrence Musson, Lon Waters, Mary Meinelt, Michael Skoufis, Mingyu "Genie" Hsieh, Nicholas Johnson, Philip Campbell, Rachel Campbell, Randall Lober, Rebecca Arnold, Regina Schells, Richard Drake, Robert Hoekstra, Roger Pawlowski, Russell Hooper, Samuel Browne, Scott Hutchinson, Simon Zou, Smitha Sam, Steven Verzi, Tamara Kolda, Timur Takhtaganov, and Todd Coffey.

Also, thanks to Hue Lai for the original typesetting of this document in LATEX.

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# **Contact Information**

Address

Electrical Models & Simulation Dept. Sandia National Laboratories P.O. Box 5800, MS 1177 Albuquerque, NM 87185-1177

Outside Sandia World Wide Web Email Inside Sandia World Wide Web Email

http://xyce.sandia.gov xyce@sandia.gov



# **CONTENTS**

| 1. | Intro | oductio  | 1  | 19 |
|----|-------|----------|--|----|
|    | 1.1.  | Overvi   | w  | 20 |
|    | 1.2.  | How to   | Use this Guide                           | 20 |
|    | 1.3.  | Typogr   | aphical conventions                      | 20 |
| 2. | Netl  | ist Refe | rence                                    | 21 |
|    | 2.1.  | Netlist  | Commands                                 | 22 |
|    |       | 2.1.1.   | . AC (AC Analysis)                       | 22 |
|    |       | 2.1.2.   | . DATA (Data Table for sweeps)           | 24 |
|    |       | 2.1.3.   | . DC (DC Sweep Analysis)                 | 25 |
|    |       |          | 2.1.3.1. Linear Sweeps                   | 25 |
|    |       |          | 2.1.3.2. Decade Sweeps                   | 25 |
|    |       |          | 2.1.3.3. Octave Sweeps                   | 25 |
|    |       |          | 2.1.3.4. List Sweeps                     | 26 |
|    |       |          | 2.1.3.5. Data Sweeps                     | 26 |
|    |       | 2.1.4.   | , 1                                      | 27 |
|    |       | 2.1.5.   | 1 6                                      | 28 |
|    |       | 2.1.6.   |  | 31 |
|    |       | 2.1.7.   |  | 32 |
|    |       | 2.1.8.   |  | 33 |
|    |       |          | 2.1.8.1. OPTIONS FFT FFT_MODE            | 35 |
|    |       |          |  | 35 |
|    |       |          | 2.1.8.3. Additional FFT Metrics          | 36 |
|    |       |          |  | 37 |
|    |       |          | 1 2                                      | 37 |
|    |       | 2.1.9.   |  | 38 |
|    |       | 2.1.10.  | . FUNC (Function)                        | 40 |
|    |       | 2.1.11.  | . GLOBAL (Global Node)                   | 42 |
|    |       | 2.1.12.  | <u> </u>                                 | 43 |
|    |       |          |  | 45 |
|    |       |          | , 1                                      | 46 |
|    |       | 2.1.15.  | .INC or .INCLUDE or .INCL (Include file) | 47 |
|    |       |          |  | 48 |
|    |       |          |  | 48 |
|    |       |          | 2.1.16.2LIB definition statement         | 48 |
|    |       |          |  | 50 |
|    |       | 2.1.18.  | 1 /                                      | 52 |
|    |       |          | 1  | 63 |
|    |       |          |  | 64 |
|    |       |          | 1 11                                     | 64 |
|    |       |          | 2.1.18.4. Re-Measure                     | 65 |

|         | 2.1.18.5. RISE, FALL                  | and CROSS Qualifiers                                    | . 66  |
|---------|---------------------------------------|---|-------|
|         | 2.1.18.6. Additional E                | xamples   | . 68  |
|         |                                       | Measure Output  |       |
|         | 2.1.18.8. ERROR Fun                   | ctions (ERR1 and ERR2)                                  | . 70  |
|         | 2.1.18.9. ERROR Mea                   | asure   | . 70  |
|         | 2.1.18.10. Operator Sup               | pport for AC Mode Measures                              | . 71  |
|         | 2.1.18.11. Operator Sup               | oport for NOISE Mode Measures                           | . 71  |
|         | 2.1.18.12. Behavior for               | Unsupported Modes and Types                             | . 72  |
|         | 2.1.18.13. Compatibilit               | y with .DATA  | . 72  |
|         | _                                     | npatibility   |       |
| 2.1.19. | .MEASURE (Continu                     | ous results)  | . 75  |
|         | 2.1.19.1. Measure Out                 | put   | . 77  |
|         |                                       | and CROSS Qualifiers                                    |       |
|         |                                       | mpatibility   |       |
| 2.1.20. |                                       | asure output for .FFT)                                  |       |
|         |                                       | initions  |       |
|         |                                       |   |       |
|         |                                       | xamples   |       |
| 2.1.21. |                                       | ition)  |       |
|         | · · · · · · · · · · · · · · · · · · · | ameter  |       |
|         |                                       | ng  |       |
|         |                                       | polation  |       |
| 2.1.22. |                                       | nate Initial Condition, Bias point)                     |       |
|         |                                       | sis)  |       |
|         |                                       | sis)  |       |
|         | •                                     | S   |       |
|         | 2.1.25.1OPTIONS                       | DEVICE (Device Package Options)                         | . 94  |
|         |                                       | TIMEINT (Time Integration Options)                      |       |
|         |                                       | NONLIN (Nonlinear Solver Options)                       |       |
|         |                                       | LOCA (Continuation and Bifurcation Tracking Package Op- |       |
|         |                                       |   | . 101 |
|         | 2.1.25.5OPTIONS                       | LINSOL (Linear Solver Options)                          | . 102 |
|         |                                       | LINSOL-HB (Linear Solver Options)                       |       |
|         |                                       | LINSOL-AC (Linear Solver Options)                       |       |
|         |                                       | OUTPUT (Output Options)                                 |       |
|         |                                       | RESTART (Checkpointing Options)                         |       |
|         |                                       | RESTART (Restarting Options)                            |       |
|         |                                       | RESTART: special notes for use with two-level-Newton    |       |
|         |                                       | SAMPLES (Sampling options)                              |       |
|         |                                       | EMBEDDEDSAMPLES (Embedded Sampling options)             |       |
|         |                                       | PCES (Fully intrusive PCE options)                      |       |
|         |                                       | SENSITIVITY (Direct and Adjoint Sensitivity Options)    |       |
|         |                                       | HBINT (Harmonic Balance Options)                        |       |
|         |                                       | DIST (Parallel Distribution Options)                    |       |
|         |                                       | FFT (FFT Options)                                       |       |
|         |                                       | MEASURE (Measure Options)                               |       |
|         |                                       | PARSER (Parser Options)                                 |       |
| 2.1.26  | . PARAM (Parameter).                  |   |       |

|      | 2.1.27. | . PCE (Fully Intrusive Polynomial Chaos Expansion (PCE) Analysis) | . 119 |
|------|---------|---|-------|
|      | 2.1.28. | .PREPROCESS REPLACEGROUND (Ground Synonym)                        | . 122 |
|      | 2.1.29. | .PREPROCESS REMOVEUNUSED (Removal of Unused Components)           | . 123 |
|      | 2.1.30. | .PREPROCESS ADDRESISTORS (Adding Resistors to Dangling Nodes)     | . 124 |
|      |         | .PRINT (Print output)   |       |
|      |         | 2.1.31.1. Print AC Analysis                                       |       |
|      |         | 2.1.31.2. Print DC Analysis                                       |       |
|      |         | 2.1.31.3. Print Harmonic Balance Analysis                         |       |
|      |         | 2.1.31.4. Print Noise Analysis                                    |       |
|      |         | 2.1.31.5. Print Transient Analysis                                |       |
|      |         | 2.1.31.6. Print Homotopy  |       |
|      |         | 2.1.31.7. Print Sensitivity                                       |       |
|      |         | 2.1.31.8. Print Embedded Sampling Analysis                        |       |
|      |         | 2.1.31.9. Print Intrusive PCE Analysis                            |       |
|      |         | 2.1.31.10. Parameter Stepping                                     |       |
|      |         | 2.1.31.11. Print Wildcards  |       |
|      |         | 2.1.31.12. Device Parameters and Internal Variables               |       |
|      | 2 1 22  |   |       |
|      | 2.1.32. | RESULT (Print results)  |       |
|      | 2 1 22  | 2.1.32.1. Example Netlist   |       |
|      |         | . SAMPLING (Sampling UQ Analysis)                                 |       |
|      |         | . SAVE (Save operating point conditions)                          |       |
|      |         | . SENS (Compute DC, AC or transient sensitivities)                |       |
|      | 2.1.36. | . STEP (Step Parametric Analysis)                                 |       |
|      |         | 2.1.36.1. Linear Sweeps   |       |
|      |         | 2.1.36.2. Decade Sweeps   |       |
|      |         | 2.1.36.3. Octave Sweeps   |       |
|      |         | 2.1.36.4. List Sweeps   |       |
|      |         | 2.1.36.5. Data Sweeps   |       |
|      |         | . SUBCKT (Subcircuit)   |       |
|      |         | . TRAN (Transient Analysis)                                       |       |
|      | 2.1.39. | Miscellaneous Commands  | . 160 |
|      |         | 2.1.39.1. * (Comment)   | . 160 |
|      |         | 2.1.39.2. ; (In-line Comment)                                     | . 160 |
|      |         | 2.1.39.3. + (Line Continuation)                                   | . 160 |
| 2.2. | Expres  | sions   | . 161 |
|      | 2.2.1.  | Expressions in .PARAM or .GLOBAL_PARAM Statements                 | . 167 |
|      | 2.2.2.  | Expressions in .PRINT Lines                                       | . 168 |
|      | 2.2.3.  | Limitations on Using Complex Values in Expressions                | . 168 |
|      | 2.2.4.  | Expressions for Device Instance and Model Parameters              | . 169 |
|      | 2.2.5.  | POLY expressions  |       |
|      |         | 2.2.5.1. Voltage-controlled sources                               |       |
|      |         | 2.2.5.2. Current-controlled sources                               |       |
|      |         | 2.2.5.3. B sources  |       |
| 2.3. | Device  | S   |       |
| •    | 2.3.1.  | Voltage Nodes   |       |
|      |         | 2.3.1.1. Global nodes   |       |
|      |         | 2.3.1.2. Subcircuit Nodes   |       |
|      | 2.3.2.  | Legal Characters in Node and Device Names.                        |       |
|      |         | Degai character in 11000 and Defree 11ames                        | . 100 |

| 2.3.3.  | Lead Currents and Power Calculations                                     | 181          |
|---------|--|--------------|
| 2.3.4.  | Capacitor  | 183          |
| 2.3.5.  | Inductor   | 188          |
| 2.3.6.  | Mutual Inductors   | 191          |
| 2.3.7.  | Resistor   | 198          |
| 2.3.8.  | Diode  | 204          |
| 2.3.9.  | Independent Current Source   | 219          |
| 2.3.10. | Independent Voltage Source   | 224          |
| 2.3.11. | Port Device  | 230          |
| 2.3.12. | Voltage Controlled Voltage Source  | 231          |
|         | Current Controlled Current Source  |              |
|         | Voltage Controlled Current Source  |              |
|         | Current Controlled Voltage Source  |              |
|         | Nonlinear Dependent Source   |              |
|         | Bipolar Junction Transistor (BJT)  |              |
|         | 2.3.17.1. The Level 1 Model  |              |
|         | 2.3.17.2. VBIC Temperature Considerations                                |              |
|         | 2.3.17.3. Level 1 BJT Tables   |              |
|         | 2.3.17.4. Level 11 and 12 BJT Tables (VBIC 1.3)                          |              |
|         | 2.3.17.5. Level 23 BJT Tables (FBH HBT_X)                                |              |
|         | 2.3.17.6. Level 230 BJT Tables (HICUM/L0)                                |              |
|         | 2.3.17.7. Level 234 BJT Table (HICUM/L2)                                 |              |
|         | 2.3.17.8. Level 504 and 505 BJT Tables (MEXTRAM)                         |              |
| 2 2 10  | Junction Field-Effect Transistor (JFET)                                  |              |
|         |  |              |
|         | Metal-Semiconductor FET (MESFET)   |              |
| 2.3.20. | MOS Field Effect Transistor (MOSFET)                                     |              |
|         | 2.3.20.1. Level 1 MOSFET Tables (SPICE Level 1)                          |              |
|         | 2.3.20.2. Level 2 MOSFET Tables (SPICE Level 2)                          |              |
|         | 2.3.20.3. Level 3 MOSFET Tables (SPICE Level 3)                          |              |
|         | 2.3.20.4. Level 6 MOSFET Tables (SPICE Level 6)                          |              |
|         | 2.3.20.5. Level 9 MOSFET Tables (BSIM3)                                  |              |
|         | 2.3.20.6. Level 10 MOSFET Tables (BSIM-SOI)                              |              |
|         | 2.3.20.7. Level 14/54 MOSFET Tables (BSIM4)                              |              |
|         | 2.3.20.8. Level 18 MOSFET Tables (VDMOS)                                 |              |
|         | 2.3.20.9. Levels 70 and 70450 MOSFET Tables (BSIM-SOI 4.6.1 and 4.5.0)   | 376          |
|         | 2.3.20.10.Level 77 MOSFET Tables (BSIM6 version 6.1.1)                   |              |
|         | 2.3.20.11.Level 102 MOSFET Tables (PSP version 102.5)                    | 467          |
|         | 2.3.20.12.Level 103 and 1031 MOSFET Tables (PSP version 103.4)           | 485          |
|         | 2.3.20.13.Level 110 MOSFET Tables (BSIM CMG version 110.0.0)             | 558          |
|         | 2.3.20.14.Level 107 and 108 MOSFET Tables (BSIM CMG versions 107.0.0 and | <b>~</b> ~ 4 |
|         | 108.0.0)   |              |
|         | 2.3.20.15.Levels 2000 and 2001 MOSFET Tables (MVS version 2.0.0)         |              |
|         | 2.3.20.16.Level 2002 MOSFET Tables (MVSG_CMC version 1.1.0)              |              |
|         | 2.3.20.17.Level 301 MOSFET Tables (EKV version 3.0.1)                    |              |
|         | 2.3.20.18.Level 10240 MOSFET Tables (L_UTSOI Version 102.4.0)            |              |
|         | Lossy Transmission Line (LTRA)   |              |
| 2.3.22. | Voltage- or Current-controlled Switch                                    | 693          |
| 2.3.23. | Generic Switch   | 696          |

|    |      | 2.3.24.  | Linear device                                       | 697 |
|----|------|----------|---|-----|
|    |      | 2.3.25.  | Lossless (Ideal) Transmission Line                  | 698 |
|    |      | 2.3.26.  | Lumped Transmission Line                            | 700 |
|    |      | 2.3.27.  | . Ideal Delay                                       | 702 |
|    |      |          | 2.3.27.1. Delay device instance parameters          | 703 |
|    |      | 2.3.28.  | Behavioral Digital Devices                          | 704 |
|    |      | 2.3.29.  | Y-Type Behavioral Digital Devices (Deprecated)      | 709 |
|    |      | 2.3.30.  | Accelerated mass                                    | 714 |
|    |      | 2.3.31.  | Power Grid  | 715 |
|    |      | 2.3.32.  | Memristor Device                                    | 726 |
|    |      | 2.3.33.  | Subcircuit  | 732 |
|    | 2.4. | TCAD     | Devices   | 733 |
|    |      | 2.4.1.   | Physical Models                                     | 743 |
|    |      |          | 2.4.1.1. Material Models and Parameters             | 743 |
|    |      |          | 2.4.1.2. Effective Mass                             | 743 |
|    |      |          | 2.4.1.3. Electron Effective Mass                    | 743 |
|    |      |          | 2.4.1.4. Hole Effective Mass                        | 743 |
|    |      |          | 2.4.1.5. Intrinsic Carrier Concentration            |     |
|    |      |          | 2.4.1.6. Bandgap                                    |     |
|    |      | 2.4.2.   | Mobility Models                                     |     |
|    |      |          | 2.4.2.1. Analytic Mobility                          |     |
|    |      |          | 2.4.2.2. Arora Mobility                             |     |
|    |      |          | 2.4.2.3. Carrier-Carrier Scattering Mobility        |     |
|    |      |          | 2.4.2.4. Lombardi Surface Mobility Model            |     |
|    |      |          | 2.4.2.5. Edge Mobilities                            |     |
|    |      |          | 2.4.2.6. Boundary Conditions for Electrode Contacts |     |
|    |      |          | 2.4.2.7. Neutral Contacts                           |     |
|    |      |          | 2.4.2.8. Schottky Contacts                          |     |
|    |      |          | 2.4.2.9. Metal-Oxide-Semiconductor Contacts         |     |
|    |      |          | 2.4.2.10. NMOS Device                               | 758 |
| 2  | Com  | ana an d | Line Avgumente                                      | 761 |
| ა. |      |          | Line Arguments                                      | _   |
|    | 3.1. | пѕрісе   | extensions  | 702 |
| 4  | Run  | time F   | nvironment  | 764 |
| •• | 4.1. | -        | ng Xyce in Serial                                   | _   |
|    | 4.2. |          | ng Xyce in Parallel                                 |     |
|    |      |          | ng Xyce on Sandia HPC and CEE Platforms             |     |
|    | 1.0. | T GIIIII | ig rigor on bunda in a una cele i autornia          | ,   |
| 5. | Sett | ing Co   | nvergence Parameters for Xyce                       | 765 |
|    | 5.1. | Adjusti  | ing Transient Analysis Error Tolerances             | 765 |
|    |      |          | Setting <b>RELTOL</b> and <b>ABSTOL</b>             |     |
|    | 5.2. |          | ing Nonlinear Solver Parameters (in transient mode) |     |
| 6  | Qui  | sk Rofe  | erence for Users of Other SPICE Circuit Simulators  | 767 |
| ٥. |      |          | ences Between Xyce and PSpice                       |     |
|    | 0.1. |          | Command Line Options                                |     |
|    |      |          | Device Support                                      | 767 |

|    |       | 6.1.3.  | .OPTIONS Support   | 767 |
|----|-------|---------|--|-----|
|    |       | 6.1.4.  | .PROBE vsPRINT   | 769 |
|    |       | 6.1.5.  | Converting PSpice ABM Models for Use in Xyce                     | 769 |
|    |       | 6.1.6.  | Usage of <b>.STEP</b> Analysis                                   | 769 |
|    |       |         | 6.1.6.1. Model Parameter Sweeps                                  | 769 |
|    |       | 6.1.7.  | Behavioral Digital Devices                                       | 770 |
|    |       | 6.1.8.  | Power Dissipation  | 770 |
|    |       | 6.1.9.  | Dependent Sources with TABLE Syntax                              | 770 |
|    |       | 6.1.10. | MODEL STATEMENTS   | 771 |
|    |       | 6.1.11. | .NODESET and .IC Statements                                      | 771 |
|    |       | 6.1.12. | Piecewise Linear Sources   | 772 |
|    |       | 6.1.13. | .AC Output   | 772 |
|    |       | 6.1.14. | Additional differences   | 773 |
|    |       |         | Translating Between PSpice and Xyce Netlists                     |     |
|    | 6.2.  |         | nces Between Xyce and Other SPICE Simulators                     |     |
|    | 6.3.  | _       | erating Point Calculation Failures in Xyce                       |     |
|    |       | 6.3.1.  | Incompatible Voltage Constraints at Circuit Nodes                |     |
|    |       | 6.3.2.  | Multiple Voltage Constraints From Subcircuits or at Global Nodes |     |
|    |       | 6.3.3.  | NODESET and IC Statements in Subcircuits                         |     |
|    |       | 6.3.4.  | No DC Path to Ground for a Current Flow                          |     |
|    |       | 6.3.5.  | Inductor Loops   |     |
|    |       | 6.3.6.  | Infinite Slope Transistions                                      |     |
|    |       | 6.3.7.  | Simulation Settings  | 779 |
| 7. | Quid  | ck Refe | rence for Microsoft Windows Users                                | 780 |
| 8. | Raw   | file Fo | rmat   | 781 |
| •  | _     |         | Format   | _   |
|    | 8.2.  |         | Format   |     |
|    |       | •       | Notes  |     |
| Re | ferer | nces    |  | 783 |
| Αp | pend  | dices   |  | 786 |
| Α. | Thir  | d Partv | Licenses   | 786 |
|    |       |         |  |     |

# **LIST OF FIGURES**

| Figure 2-1. | Model Binning Example                       | 86  |
|-------------|---|-----|
| Figure 2-2. | BJT model schematic                         | 240 |
| Figure 2-3. | VBIC thermal network schematic              | 243 |
| Figure 2-4. | Lumped Π Model for PowerGridBranch          | 723 |
| Figure 2-5. | Equivalent Circuit for PowerGridbusShunt    | 723 |
| Figure 2-6. | Equivalent Circuit for PowerGridTransformer | 725 |
| Figure 2-7. | Neutral Contacts                            | 754 |
| Figure 2-8. | Schottky Contact, N-type                    | 755 |
| Figure 2-9. | Schottky Contact, P-type                    | 756 |

# **LIST OF TABLES**

| Table 1-1.  | Xyce typographical conventions.                           | . 20  |
|-------------|---|-------|
| Table 2-1.  | .FFT Window Function Definitions (N = Number of Points)   | . 35  |
| Table 2-2.  | RISE, FALL and CROSS Support in .MEASURE                  | 67    |
| Table 2-3.  | Options for Device Package                                | . 94  |
| Table 2-4.  | Options for Time Integration Package                      | . 96  |
| Table 2-5.  | Options for Nonlinear Solver Package                      | 100   |
| Table 2-6.  | Options for Continuation and Bifurcation Tracking Package | . 101 |
| Table 2-7.  | Options for Linear Solver Package                         | 103   |
| Table 2-8.  | Options for Linear Solver Package for HB                  | . 105 |
| Table 2-9.  | Options for Sampling Package                              | . 109 |
| Table 2-10. | Options for Embedded Sampling Package                     | . 110 |
| Table 2-11. | Options for PCE Package                                   | . 111 |
| Table 2-12. | Options for Sensitivity Package                           | . 112 |
| Table 2-13. | Options for HB  | . 112 |
| Table 2-14. | Options for Parallel Distribution.                        | 114   |
| Table 2-15. | Options for FFT   | . 114 |
| Table 2-16. | Options for MEASURE                                       | . 115 |
| Table 2-17. | Options for Parsing                                       | . 116 |
| Table 2-18. | Print AC Analysis Type                                    | . 133 |
| Table 2-19. | Print DC Analysis Type                                    | . 134 |
| Table 2-20. | Print HB Analysis Type                                    | 135   |
| Table 2-21. | Print NOISE Analysis Type                                 | . 137 |
| Table 2-22. | Print Transient Analysis Type                             | . 137 |
| Table 2-23. | Print Homotopy  | . 138 |
| Table 2-24. | Print Sensitivities for .TRAN and .DC                     | . 139 |
| Table 2-25. | Print Sensitivities for .AC                               | . 139 |
| Table 2-26. | Print Transient Adjoint Sensitivities                     | . 139 |
| Table 2-27. | Print EMBEDDEDSAMPLING Analysis Type                      | 140   |
| Table 2-28. | Print PCE Analysis Type                                   | 140   |
| Table 2-31. | Operators   | 161   |
| Table 2-32. | Arithmetic Functions                                      | . 163 |
| Table 2-33. | SPICE Compatibility Functions                             | 167   |
| Table 2-34. | Analog Device Quick Reference.                            | . 173 |
| Table 2-34. | Analog Device Quick Reference.                            | . 174 |
| Table 2-35. | Features Supported by Xyce Device Models                  | . 175 |
| Table 2-36. | Capacitor Device Instance Parameters                      | . 184 |
| Table 2-37. | Capacitor Device Model Parameters                         | 185   |
| Table 2-38. | Inductor Device Instance Parameters                       | 190   |
| Table 2-39. | Inductor Device Model Parameters                          | . 190 |
| Table 2-40  | Nonlinear Mutual Inductor Device Model Parameters         | 102   |

| Table 2-41. | Resistor Device Instance Parameters                           | . 200 |
|-------------|---|-------|
| Table 2-42. | Resistor Device Model Parameters                              | . 200 |
| Table 2-43. | Resistor Device Instance Parameters                           | . 201 |
| Table 2-44. | Resistor Device Model Parameters                              | . 202 |
| Table 2-45. | Diode Device Instance Parameters                              | . 206 |
| Table 2-46. | Diode Device Model Parameters                                 |       |
| Table 2-47. | JUNCAP200 Diode Device Instance Parameters                    | . 207 |
| Table 2-48. | JUNCAP200 Diode Device Model Parameters                       |       |
| Table 2-49. | Diode level 200 Output Variables                              |       |
| Table 2-50. | ADMS DIODE_CMC Device Instance Parameters                     |       |
| Table 2-51. | ADMS DIODE_CMC Device Model Parameters                        |       |
| Table 2-52. | Diode level 2002 Output Variables                             |       |
| Table 2-53. | Pulse Parameters  |       |
| Table 2-54. | Sine Parameters   |       |
| Table 2-55. | Exponent Parameters   |       |
| Table 2-56. | Pattern Parameters  |       |
| Table 2-57. | Piecewise Linear Parameters                                   |       |
| Table 2-58. | Frequency Modulated Parameters                                |       |
| Table 2-59. | Pulse Parameters  |       |
| Table 2-60. | Sine Parameters   |       |
| Table 2-61. | Exponent Parameters   |       |
| Table 2-62. | Pattern Parameters  |       |
| Table 2-63. | Piecewise Linear Parameters                                   |       |
| Table 2-64. | Frequency Modulated Parameters                                |       |
| Table 2-64. | • •   |       |
| Table 2-65. | Bipolar Junction Transistor Device Instance Parameters        |       |
| Table 2-60. | VBIC 1.3 3T Device Instance Parameters                        |       |
| Table 2-67. | VBIC 1.3 3T Device Model Parameters                           |       |
|             |   |       |
| Table 2-69. | VBIC 1.3 4T Device Instance Parameters                        |       |
| Table 2-70. | VBIC 1.3 4T Device Model Parameters                           |       |
| Table 2-71. | FBH HBT_X v2.1 Device Instance Parameters                     |       |
| Table 2-72. | FBH HBT_X v2.1 Device Model Parameters                        |       |
| Table 2-73. | HICUM L0 v1.32 Device Instance Parameters                     |       |
| Table 2-74. | HICUM L0 v1.32 Device Model Parameters                        |       |
| Table 2-75. | BJT level 230 Output Variables                                |       |
| Table 2-76. | HICUM v2.4.0 Device Model Parameters                          |       |
| Table 2-77. | BJT level 234 Output Variables                                |       |
| Table 2-78. | MEXTRAM 504.12.1 Device Instance Parameters                   |       |
| Table 2-79. | MEXTRAM 504.12.1 Device Model Parameters                      |       |
| Table 2-80. | BJT level 504 Output Variables                                |       |
| Table 2-81. | MEXTRAM 504.12.1 with self heating Device Instance Parameters |       |
| Table 2-82. | MEXTRAM 504.12.1 with self heating Device Model Parameters    |       |
| Table 2-83. | BJT level 505 Output Variables                                |       |
| Table 2-84. | JFET Device Instance Parameters                               |       |
| Table 2-85. | JFET Device Model Parameters                                  |       |
| Table 2-86. | JFET Device Instance Parameters                               |       |
| Table 2-87. | JFET Device Model Parameters                                  |       |
| Table 2-88. | MESFET Device Instance Parameters                             | . 290 |

| Table 2-89.  | MESFET Device Model Parameters                               | . 290 |
|--------------|--|-------|
| Table 2-90.  | MOSFET level 1 Device Instance Parameters                    | . 303 |
| Table 2-91.  | MOSFET level 1 Device Model Parameters                       | . 303 |
| Table 2-92.  | MOSFET level 2 Device Instance Parameters                    | . 305 |
| Table 2-93.  | MOSFET level 2 Device Model Parameters                       | . 305 |
| Table 2-94.  | MOSFET level 3 Device Instance Parameters                    | . 307 |
| Table 2-95.  | MOSFET level 3 Device Model Parameters                       | . 307 |
| Table 2-96.  | MOSFET level 6 Device Instance Parameters                    | . 309 |
| Table 2-97.  | MOSFET level 6 Device Model Parameters                       | . 309 |
| Table 2-98.  | BSIM3 Device Instance Parameters                             | . 311 |
| Table 2-99.  | BSIM3 Device Model Parameters                                | . 312 |
| Table 2-100. | BSIM3 SOI Device Instance Parameters                         | . 325 |
| Table 2-101. | BSIM3 SOI Device Model Parameters                            | . 326 |
| Table 2-102. | BSIM4 Device Instance Parameters                             | . 346 |
| Table 2-103. | BSIM4 Device Model Parameters                                | . 347 |
| Table 2-104. | Power MOSFET Device Instance Parameters                      | . 372 |
| Table 2-105. | Power MOSFET Device Model Parameters                         | . 372 |
| Table 2-106. | BSIM-SOI 4.6.1 Device Instance Parameters                    | . 377 |
| Table 2-107. | BSIM-SOI 4.6.1 Device Model Parameters                       | . 378 |
| Table 2-108. | MOSFET level 70 Output Variables                             | . 407 |
|              | BSIM-SOI 4.5.0 Device Instance Parameters                    |       |
| Table 2-110. | BSIM-SOI 4.5.0 Device Model Parameters                       | . 409 |
| Table 2-111. | MOSFET level 70450 Output Variables                          | . 435 |
|              | BSIM6 Device Instance Parameters                             |       |
|              | BSIM6 Device Model Parameters                                |       |
|              | MOSFET level 77 Output Variables                             |       |
|              | PSP102VA legacy MOSFET 102.5 Device Instance Parameters      |       |
|              | PSP102VA legacy MOSFET 102.5 Device Model Parameters         |       |
|              | MOSFET level 102 Output Variables                            |       |
| Table 2-118. | PSP103VA MOSFET Device Instance Parameters                   | . 485 |
| Table 2-119. | PSP103VA MOSFET Device Model Parameters                      | . 486 |
| Table 2-120. | MOSFET level 103 Output Variables                            | . 514 |
|              | PSP103VA MOSFET with self-heating Device Instance Parameters |       |
| Table 2-122. | PSP103VA MOSFET with self-heating Device Model Parameters    | . 522 |
| Table 2-123. | MOSFET level 1031 Output Variables                           | . 550 |
| Table 2-124. | BSIM-CMG FINFET v110.0.0 Device Instance Parameters          | . 558 |
| Table 2-125. | BSIM-CMG FINFET v110.0.0 Device Model Parameters             | . 559 |
| Table 2-126. | MOSFET level 110 Output Variables                            | . 591 |
| Table 2-127. | BSIM-CMG FINFET v107.0.0 Device Instance Parameters          | . 595 |
| Table 2-128. | BSIM-CMG FINFET v107.0.0 Device Model Parameters             | . 596 |
| Table 2-129. | MOSFET level 107 Output Variables                            | . 623 |
| Table 2-130. | BSIM-CMG FINFET v108.0.0 Device Instance Parameters          | . 625 |
| Table 2-131. | BSIM-CMG FINFET v108.0.0 Device Model Parameters             | . 626 |
|              | MOSFET level 108 Output Variables                            |       |
|              | MVS ETSOI 2.0.0 Device Model Parameters                      |       |
| Table 2-134. | MVS HEMT 2.0.0 Device Model Parameters                       | . 659 |
| Table 2-135. | MVSG-HV HEMT MODEL Device Instance Parameters                | . 661 |
| Table 2-136  | MVSG-HV HEMT MODEL Device Model Parameters                   | 661   |

| Table 2-137. | MOSFET level 2002 Output Variables                  | 666 |
|--------------|---|-----|
|              | EKV3 MOSFET Device Instance Parameters              |     |
| Table 2-139. | EKV3 MOSFET Device Model Parameters                 | 668 |
| Table 2-140. | L_UTSOI MOSFET Device Instance Parameters           | 676 |
| Table 2-141. | L_UTSOI MOSFET Device Model Parameters              | 676 |
| Table 2-142. | MOSFET level 10240 Output Variables                 | 688 |
| Table 2-143. | Lossy Transmission Line Device Model Parameters     | 691 |
| Table 2-144. | Controlled Switch Device Model Parameters           | 695 |
|              | LIN Device Model Parameters                         |     |
| Table 2-146. | Ideal Transmission Line Device Instance Parameters  | 699 |
| Table 2-147. | Lumped Transmission Line Device Instance Parameters | 700 |
| Table 2-148. | Lumped Transmission Line Device Model Parameters    | 701 |
| Table 2-149. | Delay element Device Instance Parameters            | 703 |
| Table 2-150. | Behavioral Digital Device Instance Parameters       | 705 |
| Table 2-151. | Behavioral Digital Device Model Parameters          | 705 |
| Table 2-152. | DFF Truth-Table for DIGINITSTATE=3                  | 707 |
| Table 2-152. | DFF Truth-Table for DIGINITSTATE=3                  | 708 |
| Table 2-153. | DLTCH Truth-Table for DIGINITSTATE=3                | 708 |
|              | JKFF Truth-Table for DIGINITSTATE=3                 |     |
|              | Behavioral Digital Device Instance Parameters       |     |
| Table 2-156. | Behavioral Digital Device Model Parameters          | 710 |
|              | PowerGridBranch Device Instance Parameters          |     |
| Table 2-158. | PowerGridBusShunt Device Instance Parameters        | 718 |
| Table 2-159. | PowerGridTransformer Device Instance Parameters     | 720 |
| Table 2-160. | PowerGridGenBus Device Instance Parameters          | 722 |
| Table 2-161. | MemristorTEAM Device Instance Parameters            | 728 |
|              | MemristorTEAM Device Model Parameters               |     |
|              | MemristorYakopcic Device Instance Parameters        |     |
|              | MemristorYakopcic Device Model Parameters           |     |
| Table 2-165. | MemristorPEM Device Instance Parameters             | 730 |
| Table 2-166. | MemristorPEM Device Model Parameters                | 731 |
|              | PDE Device Model Parameters                         |     |
|              | 1D PDE (level 1) Device Instance Parameters         |     |
|              | 2D PDE (level 2) Device Instance Parameters         |     |
|              | LAYER Composite Parameters                          |     |
|              | NODE Composite Parameters                           |     |
|              | NODE Composite Parameters                           |     |
|              | DOPINGPROFILES Composite Parameters                 |     |
|              | REGION Composite Parameters                         |     |
|              | Description of the flatx, flaty doping parameters   |     |
|              | Intrinsic Carrier Concentration Parameters          |     |
|              | Bandgap constants                                   |     |
|              | Analytic Mobility Parameters                        |     |
|              | Arora Mobility Parameters                           |     |
|              | Carrier-Carrier Mobility Parameters                 |     |
|              | Lombardi Surface Mobility Parameters                |     |
|              | Material workfunction values                        |     |
| Table 2-183. | Electron affinities                                 | 757 |

| Table 3-1. | List of Xyce command line arguments | 761 |
|------------|-------------------------------------|-----|
|            | Incompatibilities with PSpice       |     |
| Table 7-1. | Issues for Microsoft Windows        | 780 |
|            | Xyce ASCII rawfile format           |     |

# 1. INTRODUCTION

# Welcome to **Xyce**™

The **Xyce**<sup>™</sup> Parallel Electronic Simulator has been written to support, in a rigorous manner, the simulation needs of the Sandia National Laboratories electrical designers. It is targeted specifically to run on large-scale parallel computing platforms but also runs well on a variety of architectures including single processor workstations. It also aims to support a variety of devices and models specific to Sandia needs.

# 1.1. Overview

This document is intended to complement the Xyce Users' Guide [1]. It contains comprehensive, detailed information about a number of topics pertinent to the usage of Xyce. Included in this document is a netlist reference for the input-file commands and elements supported within Xyce; a command line reference, which describes the available command line arguments for Xyce; and quick-references for users of other circuit codes, such as Orcad's PSpice [2].

# 1.2. How to Use this Guide

This guide is designed so you can quickly find the information you need to use Xyce. It assumes that you are familiar with basic Unix-type commands, how Unix manages applications and files to perform routine tasks (e.g., starting applications, opening files and saving your work). Note that while Windows versions of Xyce are available, they are command-line programs meant to be run under the *Command Prompt*, and are used almost identically to their Unix counterparts.

# 1.3. Typographical conventions

Before continuing in this Reference Guide, it is important to understand the terms and typographical conventions used. Procedures for performing an operation are generally indicated with the following typographical conventions.

| Notation  | Example   | Description  |  |
|---|---|--|--|
| Typewriter text                                   | mpirun -np 4  | Commands entered from the keyboard on the command line or text entered in a netlist. |  |
| <b>Bold Roman Font</b>                            | Set nominal temperature using the <b>TNOM</b> option. | SPICE-type parameters used in models, etc.   |  |
| Gray Shaded Text                                  | DEBUGLEVEL  | Feature that is designed primarily for use by Xyce developers.                       |  |
| [text in brackets]                                | <pre>Xyce [options] <netlist></netlist></pre>         | Optional parameters.   |  |
| <text angle="" brackets="" in=""></text>          | <pre>Xyce [options] <netlist></netlist></pre>         | Parameters to be inserted by the user.   |  |
| <pre><object asterisk="" with="">*</object></pre> | K1 <ind. 1=""> [<ind. n="">*]</ind.></ind.>           | Parameter that may be multiply specified.  |  |
| <text1 text2></text1 text2>                       | .PRINT TRAN<br>+ DELIMITER= <tab comma></tab comma>   | Parameters that may only take specified values.                                      |  |

Table 1-1.: Xyce typographical conventions.

# 2. NETLIST REFERENCE

# **Chapter Overview**

This chapter contains reference material directed towards working with circuit analyses in Xyce using the netlist interface. Included are detailed command descriptions, start-up option definitions and a list of devices supported by the Xyce netlist interface.

# 2.1. Netlist Commands

This section outlines the netlist commands that can be used with Xyce to setup and control circuit analysis.

# 2.1.1. .AC (AC Analysis)

Calculates the frequency response of a circuit over a range of frequencies.

The .AC command can specify a linear sweep, decade logarithmic sweep, octave logarithmic sweep, or a data table of multivariate values.

```
General Form

.AC <sweep type> <points value>
+ <start frequency value> <end frequency value>

Examples

.AC LIN 101 100Hz 200Hz
.AC OCT 10 1kHz 16kHz
.AC DEC 20 1MEG 100MEG
.AC DATA=
```

# Arguments and Options

sweep type

Must be LIN, OCT, DEC, or DATA as described below.

LIN Linear sweep

The sweep variable is swept linearly from the starting to the ending value.

OCT Sweep by octaves

The sweep variable is swept logarithmically by octaves.

DEC Sweep by decades

The sweep variable is swept logarithmically by decades.

DATA Sweep values from a table

Sweep variables are applied based on the rows of a data table. This format allows magnitude and phase to be swept in addition to frequency. If using this format, no other arguments are needed on the .AC line.

points value

Specifies the number of points in the sweep, using an integer greater than or equal to 1.

```
start frequency value end frequency value
```

The end frequency value must not be less than the start frequency value, and both must be greater than zero. The whole sweep must include at least one point.

# **Comments**

AC analysis is a linear analysis. The simulator calculates the frequency response by linearizing the circuit around the DCOP bias point.

If specifying the sweep points using the DATA type, one can also sweep the magnitude and phase of an AC source, as well as the values of linear model parameters. However, unlike the use of DATA for .STEP and .DC, it is not possible to sweep nonlinear device parameters. This is because changing other nonlinear device parameters would alter the correct DCOP solution, and the AC sweep happens after the DCOP calculation in the analysis flow. To sweep a nonlinear device parameter on an AC problem, add a .STEP command to the netlist to provide an outer parametric sweep around the analysis.

A .PRINT AC must be used to get the results of the AC sweep analysis. See Section 2.1.31.

Some devices that may be expected to work in AC analysis do not at this time. This includes, but is not limited to, the lossy transmission line (LTRA) and lossless transmission line (TRA). The LTRA and TRA models will need to be replaced with lumped transmission line models (YTRANSLINE).

Power calculations (P (<device>) and W (<device>) are not supported for any devices for AC analysis. Current variables (e.g., I (<device>)) are only supported for devices that have "branch currents" that are part of the solution vector. This includes the V, E, H and L devices. It also includes the voltage-form of the B device.

# 2.1.2. . DATA (Data Table for sweeps)

User-defined data table, which can be used to specify sweep points for .AC, .DC, .NOISE or .STEP

#### **General Form**

```
.DATA [<name>]
```

+ <parameter name> [parameter name] \*
+ <parameter value> [parameter value] \*

.ENDDATA

# **Examples**

```
.data test
```

+ r1 r2

+ 8.0000e+00 4.0000e+00 + 9.0000e+00 4.0000e+00

.enddata

# Arguments and Options

name

Name of the data table.

parameter name

Name of sweep parameter. This can be a device instance parameter, a device model parameter or a user-defined parameter specified using

.GLOBAL\_PARAM or a globally scoped .PARAM statement.

parameter value

Value of sweep parameter for the given sweep point. This must be a double precision number. Each row of the table corresponds to a different sweep step, so multiple parameters can be changed simultaneously.

#### **Comments**

Each column of a data table corresponds to a different parameter, and each row corresponds to a different sweep point.

If using . DATA with . DC or . STEP, then any instance parameter, model parameter, or user-defined parameter in the global scope.

However, if using .DATA with .AC or .NOISE, then one can sweep the magnitude and phase of an AC source, and linear model parameters (such as resistance and capacitance) in addition to the traditional AC sweep variable, frequency. Parameters associated with nonlinear models (like transistors) are not allowed. This is because AC analysis is a linear analysis, performed after the DCOP calculation. Changing nonlinear device model parameters would result in a different DCOP solution, so changing them during the AC (or NOISE) analysis phase is not valid.

Another caveat, for both .AC and .NOISE, is that all of the frequency values in the data table must be positive. If .DATA is used with .NOISE then the integrals for the total input noise and total output noise will only be calculated, and sent to stdout, if the frequencies in the data table are monotonically increasing.

# 2.1.3. . DC (DC Sweep Analysis)

Calculates the operating point for the circuit for a range of values. Primarily, this capability is applied to independent voltage sources, but it can also be applied to most device parameters. Note that this may be repeated for multiple sources in the same <code>.DC</code> line.

The .DC command can specify a linear sweep, decade logarithmic sweep, octave logarithmic sweep, a list of values, or a data table of multivariate values.

# 2.1.3.1. Linear Sweeps

#### 

# Examples .DC LIN V1 5 25 5 .DC VIN -10 15 1

.DC R1 0 3.5 0.05 C1 0 3.5 0.5

# **Comments**

A .PRINT DC must be used to get the results of the DC sweep analysis. See Section 2.1.31.

A .OP comand will result in a linear DC analysis if there is no .DC specified.

If the stop value is smaller than the start value, the step value should be negative. If a positive step value is given in this case, only a single point (at the start value) will be performed, and a warning will be emitted.

# 2.1.3.2. Decade Sweeps

# General Form .DC DEC <sweep variable name> <start> <stop> <points>

+ [DEC <sweep variable name> <start> <stop> <points>]\*

## Examples .DC DEC VIN 1 100 2

.DC DEC R1 100 10000 3 DEC VGS 0.001 1.0 2

#### **Comments**

The stop value should be larger than the start value. If a stop value smaller than the start value is given, only a single point at the start value will be performed, and a warning will be emitted. The points value must be an integer.

## 2.1.3.3. Octave Sweeps

#### 

# Examples .DC OCT VIN 0.125 64 2

.DC OCT R1 0.015625 512 3 OCT C1 512 4096 1

#### **Comments**

The stop value should be larger than the start value. If a stop value smaller than the start value is given, only a single point at the start value will be performed, and a warning will be emitted. The points value must be an integer.

# 2.1.3.4. **List Sweeps**

# $\textbf{General Form} \qquad \textbf{.} \texttt{DC < sweep variable name} \texttt{LIST < val} \texttt{< val} \texttt{>} \star \texttt{}$

+ [ <sweep variable name> LIST <val> \* ]\*

# Examples .DC VIN LIST 1.0 2.0 5.0 6.0 10.0

.DC VDS LIST 0 3.5 0.05 VGS LIST 0 3.5 0.5

.DC TEMP LIST 10.0 15.0 18.0 27.0 33.0

# 2.1.3.5. Data Sweeps

General Form .DC DATA=<data table name>

# **Examples**

- .DC data=resistorValues
- .data resistorValues
- + r1 r2
- + 8.0000e+00 4.0000e+00
- + 9.0000e+00 4.0000e+00
- .enddata

# 2.1.4. . DCVOLT (Initial Condition, Bias point)

The .DCVOLT sets initial conditions for an operating point calculation. It is identical in function to the .  $\cite{IC}$  command. See section 2.1.14 for detailed guidance.

# 2.1.5. . EMBEDDEDSAMPLING (Embedded Sampling)

.EMBEDDEDSAMPLING

**General Form** 

Calculates a full analysis (for .DC or .TRAN only) over a distribution of parameter values. Embedded sampling operates similarly to .STEP, except that the parameter values are generated from random distributions rather than sweeps, and that the loop over parameters happens at the inner-most part of the calculation, so all samples are propagated simultaneously. If used in conjunction with projection-based PCE methods, then the sample points are not based on random samples. Instead they are based on the quadrature points.

+ param=<parameter name>, [parameter name] \*
+ type=<parameter type>, [parameter type] \*

```
+ means=<mean>, [mean] *
              + std_deviations=<standard deviation>, [standard
              deviation] *
              + lower bounds=<lower bound>, [lower bound] *
              + upper_bounds=<upper bound>, [upper bound] *
              + alpha=<alpha>, [alpha] *
              + beta=<beta>, [beta] *
Examples
              .EMBEDDEDSAMPLING
              + param=R1
              + type=normal
              + means=3K
              + std_deviations=1K
               .EMBEDDEDSAMPLING
              + param=R1,R2
              + type=uniform, uniform
              + lower bounds=1K,2K
              + upper_bounds=5K,6K
               .EMBEDDEDSAMPLING
              + useExpr=true
               .options EMBEDDEDSAMPLES numsamples=10000
              .options EMBEDDEDSAMPLES numsamples=25000
              + OUTPUTS={R1:R}, {V(1)}
              + SAMPLE_TYPE=MC
              .options EMBEDDEDSAMPLES numsamples=1000
              + MEASURES=maxSine
              + SAMPLE_TYPE=LHS
              .options embeddedsamples numsamples=30
```

+ covmatrix=1e6, 1.0e-3, 1.0e-3, 4e-14

# Arguments and Options

#### param

Names of the parameters to be sampled. This may be any of the parameters that are valid for .STEP, including device instance, device model, or global parameters. If more than one parameter, then specify as a comma-separated list.

# type

Distribution type for each parameter. This may be uniform, normal or gamma. If more than one parameter, then specify as a comma-separated list.

#### means

If using normal distributions, the mean for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

#### std deviations

If using normal distributions, the standard deviation for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

# lower\_bounds

If using uniform distributions, the lower bound must be specified. This is optional for normal distributions. If used with normal distributions, may alter the mean and standard deviation. If more than one parameter, then specify as a comma-separated list.

# upper\_bounds

If using uniform distributions, the upper bound must be specified. This is optional for normal distributions. If used with normal distributions, may alter the mean and standard deviation. If more than one parameter, then specify as a comma-separated list.

## alpha

If using gamma distributions, the alpha value for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

## beta

If using gamma distributions, the beta value for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

#### useExpr

If this argument is set to true, then the sampling algorithm will set up random inputs from expression operators such as AGAUSS and AUNIF. In this case it will also ignore the list of parameters on the .EMBEDDEDSAMPLING command line. For a complete description of expression-based random operators, see the expression documentation in section 2.2.

# **Comments**

In addition to the .EMBEDDEDSAMPLING command, this analysis requires a .options EMBEDDEDSAMPLES command as well. The .EMBEDDEDSAMPLING command specifies parameters and their attributes, either using the useExpr option, or with comma-separated lists. The .options EMBEDDEDSAMPLES command specifies analysis options, including the number of samples, the type of sampling (LHS or MC) and the outputs and/or measures for which to compute statistics. This line also allows one to specify a non-intrusive Polynomial Chaos Expansion (PCE) method (either regression or projection PCE). To see the details of the .options EMBEDDEDSAMPLES command, see table 2-10.

On the .EMBEDDEDSAMPLING command line, if not using useExpr, parameters and their attributes must be specified using comma-separated lists. The comma-separated lists must all be the same length.

The .PRINT ES command provides output based on the contents of those print-lines, and also the NUMSAMPLES and OUTPUT arguments on the .OPTIONS EMBEDDEDSAMPLES line. If the OUTPUT\_SAMPLE\_STATS argument on a .PRINT ES line is set to "true" then the statistics for the MEAN, MEANPLUS, MEANMINUS, STDDEV and VARIANCE will be output for each variable in the OUTPUT argument. If the OUTPUT\_ALL\_SAMPLES argument on a .PRINT ES line is set to "true" then the values of all NUMSAMPLES samples, for each variable requested in the OUTPUTS argument, will be output.

# 2.1.6. . END (End of Circuit)

Marks the end of netlist file.

# 2.1.7. . ENDS (End of Subcircuit)

Marks the end of a subcircuit definition.

# 2.1.8. . FFT (FFT Analysis)

Performs Fast Fourier Transform analysis of transient analysis output.

## **General Form**

```
.FFT <ov> [NP=<value>] [WINDOW=<value>] [ALFA=<value>]
+ [FORMAT=<value>] [START=<value>] [STOP=<value>]
+ [FREQ=value] [FMIN=value] [FMAX=value]
```

# **Examples**

```
.FFT v(1)
.FFT v(1,2) NP=512 WINDOW=HANN
.FFT \{v(3)-v(2)\}\ START=1 STOP=2
```

# Arguments and Options

- ov The desired solution output to be analyzed. Only one output variable can be specified on a .FFT line. However, multiple .FFT lines with the same output variable but, for example, different windowing functions may be used in a netlist. The available outputs are:
  - V (<circuit node>) the voltage at <circuit node>
  - V(<circuit node>, <circuit node>) to output the voltage difference between the first <circuit node> and second <circuit node>
  - I (<device>) the current through a two terminal device
  - I<lead abbreviation> (<device>) the current into a particular lead of a three or more terminal device (see the Comments, below, for details)
  - N (<device parameter>) a specific device parameter (see the individual devices in Section 2.3 for syntax)
- NP The number of points in the FFT. This value must be a power of 2. If the user-entered value is not a power of two then it will be rounded to the nearest power of 2. The minimum allowed value of NP is 4. The default value is 1024.

#### WINDOW

The windowing function that will be applied to the sampled waveform values. The allowed values are as follows, where table 2-1 gives their exact definitions:

- RECT (or RECTANGULAR) = rectangular window (default)
- BART (or BARTLETT) = Bartlett (triangular) window
- BARTLETTHANN = Bartlett-Hann window
- BLACK = Blackman window
- BLACKMAN = "Conventional Blackman" window
- HAMM (or HAMMING) = Hamming window

- HANN (or HANNING) = Hanning window
- HARRIS (or BLACKMANHARRIS) = Blackman-Harris window
- NUTTALL = Nuttall window
- COSINE2 = Power-of-cosine window, with exponent 2.
- COSINE4 = Power-of-cosine window, with exponent 4.
- HALFCYCLESINE = Half-cycle sine window
- HALFCYCLESINE3 = Half-cycle sine window, with exponent 3.
- HALFCYCLESINE 6 = Half-cycle sine window, with exponent 6.

#### ALFA

This parameter is supported for HSPICE compatibility. It currently has no effect though, since the GAUSS and KAISER windows are not supported.

#### FORMAT

The allowed values are NORM and UNORM. If NORM is selected then the magnitude values will be normalized to the largest magnitude. If UNORM is selected then the actual magnitude values will be output instead. The default value for this parameter depends on the .OPTIONS FFT FFT\_MODE setting. If FFT\_MODE=0, which is the default options setting, then the default value is NORM. If FFT MODE=1 then the default value is UNORM.

#### START

The start time for the FFT analysis. The default value is the start time for the transient analysis. FROM is an allowed synonym for START.

### STOP

The end time for the FFT analysis. The default value is the end time for the transient analysis. TO is an allowed synonym for STOP.

# FREO

The "first harmonic" of the frequencies provided in the output file. The default value for FREQ is 1/(STOP - START). If FREQ is given then it is rounded to the nearest integer multiple of the default value. The Xyce Users' Guide [1] provides an example.

### FMIN

This parameter can use to adjust the harmonics included in the "additional metrics" defined in Section 2.1.8.3. It has a default value of 1.

#### **FMAX**

This parameter can use to adjust the harmonics included in the "additional metrics" defined in Section 2.1.8.3. It has a default value of NP/2.

#### **Comments**

Multiple . FFT lines may be used in a netlist. All results from FFT analyses will be returned to the user in a file with the same name as the netlist file suffixed with . fftX where X is the step number.

<lead abbreviation> is a single character designator for individual leads on a
device with three or more leads. For bipolar transistors these are: c (collector), b

(base), e (emitter), and s (substrate). For mosfets, lead abbreviations are: d (drain), g (gate), s (source), and b (bulk). SOI transistors have: d, g, s, e (bulk), and b (body). For PDE devices, the nodes are numbered according to the order they appear, so lead currents are referenced like I1(<device>), I2(<device>), etc.

For this analysis, the phase data is always output in degrees.

In Xyce, WINDOW=TRIANGULAR is not an allowed synonym for WINDOW=BART. This is to avoid confusion with other analysis packages such as SciPy and Matlab.

# 2.1.8.1. .OPTIONS FFT FFT MODE

The setting for .OPTIONS FFT FFT\_MODE is used to control whether the Xyce FFT processing and output are more compatible with HSPICE (0) or Spectre (1). This setting affects the format of the window functions, the conversion from two-sided to one-sided results, and whether the default output for the magnitude values is normalized, or not. The default setting for FFT\_MODE is 0.

If FFT\_MODE=0 then symmetric window functions are used. If FFT\_MODE=1 then periodic window functions are used. The next subsection provides more details on that difference.

If FFT\_MODE=0 then the two-sided to one-sided conversion doubles the magnitudes of the 1,2,...,NP harmonics. If FFT\_MODE=1 then that conversion only doubles the magnitudes of the 1,2,...,(NP-1) harmonics.

The default value for the FORMAT parameter depends on the .OPTIONS FFT FFT\_MODE setting. If FFT\_MODE=0 then the default value for that parameter is NORM. If FFT\_MODE=1 then the default value is UNORM.

## 2.1.8.2. Window Functions

Table 2-1 gives the definitions of the window functions implemented in Xyce. For HSPICE compatibility, the BLACK window type is actually the "-67 dB Three-Term Blackman-Harris window" [3] rather than the "Conventional Blackman Window" used by Spectre, Matlab and SciPy. The Convential Blackman Window can be selected with the Blackman window type instead. The definition of the BART window type [4] was chosen to match Spectre, Matlab and SciPy. The Xyce definition may differ from HSPICE.

As mentioned in the previous subsection, the choice of symmetric vs. periodic window functions can be selected via the use of .OPTIONS FFT FFT\_MODE=<0|1>. If symmetric windows are used then L = N - 1 in the formulas in table 2-1, where N is the number of points in the FFT. If periodic windows are used then L = N.

| Value        | Description       | Definition   |  |  |  |
|--------------|-------------------|--|--|--|--|
| RECT         | Rectangular       | $w(i) = 1,  \text{for } 0 \le i < N$   |  |  |  |
| BART         | Barlett [4]       | $w(i) = \begin{cases} \frac{2i}{L}, & \text{if } i < 0.5 \cdot (N-1) \\ 2 - \frac{2i}{L}, & \text{otherwise} \end{cases}$    |  |  |  |
| BARTLETTHANN | Bartlett-Hann [3] | $ w(i) = 0.62 - 0.48 \cdot  \frac{i}{L} - 0.5  + 0.38 \cdot \cos(2\pi \cdot (\frac{i}{L} - 0.5)), \text{ for } 0 \le i < N $ |  |  |  |

Table 2-1. .FFT Window Function Definitions (N = Number of Points).

| Value          | Description  | Definition   |
|----------------|--|--|
| HANN           | Hanning [4]  | $w(i) = \sin^2(\frac{\pi i}{L}), \text{ for } 0 \le i < N$   |
| HAMM           | Hamming [4]  | $w(i) = 0.54 - 0.46 \cdot \cos(\frac{2\pi i}{L}), \text{ for } 0 \le i < N$  |
| BLACKMAN       | "Conventional<br>Blackman window" [3]                            | $w(i) = 0.42 - 0.5 \cdot \cos(\frac{2\pi i}{L}) + 0.08 \cdot \cos(\frac{4\pi i}{L}), \text{ for } 0 \le i < N$   |
| BLACK          | -67 dB Three-Term<br>Blackman-Harris<br>window [3]               | $w(i) = 0.42323 - 0.49755 \cdot cos(\frac{2\pi i}{L}) + 0.07922 \cdot cos(\frac{4\pi i}{L}), \text{ for } 0 \le i < N$   |
| HARRIS         | -92 dB Four-Term<br>Blackman-Harris<br>window [3]                | $w(i) = 0.35875 - 0.48829 \cdot cos(\frac{2\pi i}{L}) + 0.14128 \cdot cos(\frac{4\pi i}{L}) - 0.01168 \cdot cos(\frac{6\pi i}{L}),  \text{for } 0 \le i < N$         |
| NUTTALL        | Four-Term Nuttall,<br>Minimum Sidelobe<br>(Blackman-Nuttall) [3] | $w(i) = 0.3635819 - 0.4891775 \cdot cos(\frac{2\pi i}{L}) + 0.1365995 \cdot cos(\frac{4\pi i}{L}) - 0.0106411 \cdot cos(\frac{6\pi i}{L}), \text{ for } 0 \le i < N$ |
| COSINE2        | Power-of-cosine<br>window, with exponent<br>2                    | $w(i) = 0.5 - 0.5 \cdot cos(\frac{2\pi i}{L}), \text{ for } 0 \le i < N$   |
| COSINE2        | Power-of-cosine<br>window, with exponent<br>4                    | $w(i) = 0.375 - 0.5 \cdot \cos(\frac{2\pi i}{L}) + 0.125 \cdot \cos(\frac{4\pi i}{L}), \text{ for } 0 \le i < N$   |
| HALFCYCLESINE  | Half-cycle sine window   | $w(i) = \sin(\frac{\pi i}{L})$   |
| HALFCYCLESINE3 | Half-cycle sine window, with exponent 3                          | $w(i) = \sin^3(\frac{\pi i}{L})$   |
| HALFCYCLESINE6 | Half-cycle sine window, with exponent 6                          | $w(i) = \sin^6(\frac{\pi i}{L})$   |

# 2.1.8.3. Additional FFT Metrics

The following additional metrics will be sent to stdout if .OPTIONS FFT FFTOUT=1 is used in the netlist. These definitions are also used by the corresponding measure types on .MEASURE FFT lines.

Define the integer index of the "first harmonic" ( $f_0$ ) as follows (where it has a default value of 1 and the ROUND() function rounds to the nearest integer):

$$f_0 = \begin{cases} ROUND(\frac{FREQ}{STOP - START}), & \text{if FREQ given} \\ 1, & \text{otherwise} \end{cases}$$

Finally, define mag[i] as the magnitude of the FFT coefficient at index i, and N as the number of points in the FFT.

The Signal to Noise-plus-Distortion Ratio (SNDR) is calculated as follows, where the summation in the denominator includes all of the frequencies except for the first harmonic frequency  $f_0$ :

$$SNDR = 20 \cdot log 10(\frac{mag[f_0]}{sqrt(\sum mag[i]*mag[i])}), \ \ \text{for} \ 1 \leq i \leq 0.5 \cdot N \ , \ \text{and} \ i \neq f_0$$

The Effective Number of Bits (ENOB) is calculated as follows, where the units is "bits":

$$ENOB = \frac{SNDR - 1.76}{6.02}$$

For the Signal to Noise Ratio (SNR) metric define the upper frequency limit for the SNR metric as follows, with the caveat that if  $f_2$  is less than  $f_0$  then its value is set to  $f_0$ :

$$f_2 = \begin{cases} ROUND(\frac{FMAX}{STOP - START}), & \text{if FMAX given} \\ 0.5 \cdot N, & \text{otherwise} \end{cases}$$

The SNR is then calculated as follows, where the summation in the denominator only uses indexes that are either not an integer-multiple of  $f_0$  or that are greater than the upper frequency limit of  $f_2$ . (Note: for the default case of  $f_0 = 1$  and FMAX not given there are no "noise frequencies".)

$$SNR = 20 \cdot log 10(\frac{mag[f_0]}{sqrt(\sum mag[i]*mag[i])}), \text{ for } i > f_2 \text{ or } i\% f_0 \neq 0$$

For the Total Harmonic Distortion (THD) metric define the upper frequency limit ( $f_2$ ) in the summation in the numerator as:

$$f_2 = \begin{cases} ROUND(\frac{FMAX}{STOP - START}), & \text{if FMAX given} \\ 0.5 \cdot N, & \text{otherwise} \end{cases}$$

The THD is then calculated using only the indexes that are multiples of  $f_0$ . So, if  $f_0$ =2 then the summation in the numerator would only include indexes 4,6,8,etc.

$$THD = 20 \cdot log \ 10 \big( \frac{sqrt(\sum mag[i]*mag[i])}{mag[f_0]} \big), \quad \text{for} \ 2 \cdot f_0 \leq i \leq f_2 \ \text{, and} \ i\% f_0 = 0$$

For Spurious Free Distortion Ratio (SFDR) metric define the upper and lower frequency limits ( $f_2$  and  $f_1$ ) considered in the denominator of the calculation as:

$$f_2 = \begin{cases} ROUND(\frac{FMAX}{STOP - START}), & \text{if FMAX given} \\ 0.5 \cdot N, & \text{otherwise} \end{cases}$$

and:

$$f_1 = \left\{ \begin{array}{ll} ROUND(\frac{FMIN}{STOP-START}), & \text{if FMIN given} \\ f_0, & \text{if FMIN not given, and } f_2 \geq f_0 \\ 1, & \text{if FMIN not given, and } f_2 < f_0 \end{array} \right.$$

The SFDR is then calculated as:

$$SFDR = 20 \cdot log 10(\frac{mag[f_0]}{MAX(mag[i])}), \ \ \text{for} \ f_1 \leq i \leq f_2 \ , \ \text{and} \ i \neq f_0$$

# 2.1.8.4. Re-Measure

Xyce can re-calculate (or re-measure) the values for .FFT statements using existing Xyce output files. Section 2.1.18.4 discusses this topic in more detail for both .MEASURE and .FFT statements. One additional caveat is that FFT\_ACCURATE is set to 0 during the re-measure operation. This should have no impact of the accuracy of the re-measured results if the output file was previously generated with FFT\_ACCURATE set to 1.

# 2.1.8.5. Compatibility Between OUTPUT and FFT Options

Some .OPTIONS OUTPUT settings are incompatible with using the default setting of .OPTIONS FFT FFT\_ACCURATE=1. The use of .OPTIONS OUTPUT OUTPUTTIMEPOINTS is compatible. However, the use of .OPTIONS OUTPUT INITIAL\_INTERVAL is not. In that latter case, .OPTIONS FFT FFT\_ACCURATE will be automatically set to 0.

# 2.1.9. . FOUR (Fourier Analysis)

Performs Fourier analysis of transient analysis output.

General Form .FOUR <freq> <ov> [ov] \*

# Examples .FOUR 100K v(5)

.FOUR 1MEG v(5,3) v(3)

.FOUR 20MEG SENS

.FOUR 40MEG  $\{v(3)-v(2)\}$ 

# Arguments and Options

freq

The fundamental frequency used for Fourier analysis. Fourier analysis is performed over the last period (1/freq) of the transient simulation. The DC component and the first nine harmonics are calculated.

- ov The desired solution output, or outputs, to be analyzed. Fourier analysis can be performed on several outputs for each fundamental frequency, freq. At least one output must be specified in the .FOUR line. The available outputs are:
  - V (<circuit node>) the voltage at <circuit node>
  - V(<circuit node>, <circuit node>) to output the voltage difference between the first <circuit node> and second <circuit node>
  - I (<device>) the current through a two terminal device
  - I<lead abbreviation>(<device>) the current into a particular lead of a three or more terminal device (see the Comments, below, for details)
  - N (<device parameter>) a specific device parameter (see the individual devices in Section 2.3 for syntax)
  - SENS transient direct sensitivities (see Section 2.1.35 for more details about setting up the .SENS command)

## **Comments**

Multiple . FOUR lines may be used in a netlist.

All results from Fourier analysis will be returned to the user in a file with the same name as the netlist file suffixed with .four#, where the suffixed number (#) starts at 0 and increases for multiple iterations (.STEP iterations) of a given simulation.

<lead abbreviation> is a single character designator for individual leads on a
device with three or more leads. For bipolar transistors these are: c (collector), b
(base), e (emitter), and s (substrate). For mosfets, lead abbreviations are: d (drain), g
(gate), s (source), and b (bulk). SOI transistors have: d, g, s, e (bulk), and b (body).

For PDE devices, the nodes are numbered according to the order they appear, so lead currents are referenced like I1(<device>), I2(<device>), etc.

For this analysis, the phase data is always output in degrees.

# 2.1.10. . FUNC (Function)

User defined functions that can be used in expressions appearing later in the same scope as the .FUNC statement.

General Form .FUNC <name>([arg]\*) {<body>}

# **Examples**

```
.FUNC E(x) {exp(x)}
.FUNC DECAY(CNST) {E(-CNST*TIME)}
.FUNC TRIWAV(x) {ACOS(COS(x))/3.14159}
.FUNC MIN3(A,B,C) {MIN(A,MIN(B,C))}
```

# Arguments and Options

name

Function name. Functions cannot be redefined and the function name must not be the same as any of the predefined functions (e.g., SIN and SQRT).

arg

The arguments to the function. FUNC arguments cannot be node names. The number of arguments in the use of a function must agree with the number in the definition. Parameters, TIME, FREQ, and other functions are allowed in the body of function definitions. Two constants EXP and PI cannot be used a argument names. These constants are equal to e and  $\pi$ , respectively, and cannot be redefined.

body

May refer to other (previously defined) functions; the second example, DECAY, uses the first example, E.

## **Comments**

The <body> of a defined function is handled in the same way as any math expression; it must be enclosed in curly braces.

The scoping rules for functions are:

- If a .FUNC, statement is included in the main circuit netlist, then it is accessible from the main circuit and all subcircuits.
- .FUNC statements defined within a subcircuit are scoped to that subcircuit definition. So, their functions are only accessible within that subcircuit definition, as well as within "nested subcircuits" also defined within that subcircuit definition.

Additional illustative examples of scoping are given in the "Working with Subcircuits and Models" section of the Xyce Users' Guide [1].

Rules for function names are as follows:

• They should start with a letter or the underscore (\_) character, for maximal compatibilty with other Spice-like simulators. The hash (#) at (@) and backtick ( `) symbols also work, but they are not reserved characters.

- These arithmetic operators % ^ & ~ \* + < > / | should not be used anywhere in function names, as they cause problems with expression parsing.
- Parentheses ("(" or ")"), braces ("{" or "}"), commas, semi-colons, double quotes and single quotes are also not allowed.

# 2.1.11. . GLOBAL (Global Node)

The .GLOBAL command provides another way to designate certain nodes as global nodes, besides starting their node name with the two characters "\$G" as discussed in section 2.3.1. A typical usage of such global nodes is to define a VDD or VSS signal that all subcircuits need to be able to access, but without having to provide VSS and VDD input nodes to every subcircuit.

```
General Form

.GLOBAL <node>

Examples

.GLOBAL g1
.subckt rsub a b
Rab a b 2
* since node G1 is global, it may be used here without
* being listed on the .subckt line
Rbg G1 b 3
.ends
```

**Comments** 

The name of the global node can be any legal node name, per section 2.3.2.

# 2.1.12. . GLOBAL\_PARAM (Global parameter)

User-defined global parameter that can be used in expressions throughout the netlist.

**General Form** 

.GLOBAL\_PARAM [<name>=<value>] \*

# **Examples**

```
.GLOBAL_PARAM T = \{27 + 100 * time\}
```

name value

The name of a global parameter and its value. The value may be an expression.

## **Comments**

A .PARAM defined in the top level netlist is equivalent to a .GLOBAL\_PARAM, and they can be combined as needed. Thus, you may use parameters defined by .PARAM in expressions used to define global parameters, and you may also use global parameters in .PARAM definitions. However, a .GLOBAL\_PARAM can only depend on .PARAM parameter from the top level circuit scope.

Like .PARAM parameters, .GLOBAL\_PARAM may depend on time dependent quantities in the circuit. They may also be frequency dependent. They cannot, however, be dependent on solution variaables such as voltage nodes.

To load an external data file with time voltage pairs of data on each line into a global parameter, use this syntax:

```
.GLOBAL_PARAM extdata = {tablefile("filename")}
or
.GLOBAL_PARAM extdata = {table("filename")}
```

where filename would be the name of the file to load. Other interpolators that can read in a data table from a file include fasttable, spline, akima, cubic, wodicka and bli. See 2.2 for further information.

There are several reserved words that may not be used as names for parameters. These reserved words are:

- Time
- Freq
- Hertz
- Vt
- Temp
- Temper
- GMIN

Global parameters are accessible, and have the same value, throughout all levels of the netlist hierarchy. It is not legal to redefine global parameters in different levels of the netlist hierarchy. Also, global parameters can only be defined in the top level circuit scope. Parameters defined inside of subcircuits must be of the . PARAM type.

# 2.1.13. . HB (Harmonic Balance Analysis)

Calculates steady states of nonlinear circuits in the frequency domain.

General Form .HB <fundamental frequencies>

Examples .HB 1e4

.hb 1e4 2e2

Arguments and Options

fundamental frequencies

Sets the fundamental frequencies for the analysis.

**Comments** 

Harmonic balance analysis calculates the magnitude and phase of voltages and currents in a nonlinear circuit. Use a <code>.OPTIONS HBINT</code> statement to set additional harmonic balance analysis options.

The .PRINT HB statement must be used to get the results of the harmonic balance analysis. See section 2.1.31.

Some devices that may be expected to work in HB analysis do not at this time. This includes some use cases of B sources (but not all). A time-dependent B source will not work with HB. However, a B source that is purely dependent (such as a nonlinear resistor) will work. This same guidance applies to the E,F,G, and H dependent sources.

# 2.1.14. . IC (Initial Condition, Bias point)

The .IC/.DCVOLT command sets initial conditions for operating point calculations. These operating point conditions will be enforced the entire way through the nonlinear solve. Initial conditions can be given for some or all of the circuit nodes.

As the conditions are enforced for the entire solve, only the nodes not specified with .IC statements will change over the course of the operating point calculation.

Note that it is possible to specify conditions that are not solvable. Consult the Xyce Users' Guide [1] for more guidance.

# **General Form**

.IC  $V(\langle node \rangle) = \langle value \rangle$ 

.IC <node> <value>

.DCVOLT V(<node>) = <value>

.DCVOLT <node> <value>

# **Examples**

.IC V(2) = 3.1

.IC 2 3.1

.DCVOLT V(2) = 3.1

.DCVOLT 2 3.1

## **Comments**

The .IC capability can only set voltage values, not current values.

The . IC capability can not be used within subcircuits to set voltage values on global nodes.

# 2.1.15. . INC or . INCLUDE or . INCL (Include file)

Include specified file in netlist.

The file name can be surrounded by single or double quotes, 'filename' or "filename", but this is not necessary. The directory for the include file is assumed to be the execution directory unless a full or relative path is given as a part of the file name.

## **General Form**

```
.INC <include file name>
.INCLUDE <include file name>
.INCL <include file name>
```

# **Examples**

```
.INC models.lib
.INC 'models.lib'
.INC "models.lib"
.INCLUDE models.lib
.INCLUDE 'models.lib'
.INCLUDE "path_to_library/models.lib"
```

## **Comments**

If <include file name> uses an absolute path then that path is used. Otherwise, the search-path order for <include file name> is:

- Relative to the directory that contains <include file name>.
- Relative to the directory that contains the file with the top-level netlist.
- Relative to the Xyce execution directory.

# 2.1.16. . LIB (Library file)

The .LIB command is similar to .INCLUDE, in that it brings in an external file. However, it is designed to only bring in specific parts of a library file, as designated by an entry name. Note that the Xyce version of .LIB has been designed to be compatible with HSPICE [5], not PSpice [6].

There are two forms of the . LIB statement, the call and the definition. The call statement reads in a specified subset of a library file, and the definition statement defines the subsets.

## 2.1.16.1. .LIB call statement

```
General Form

.LIB <file name> <entry name>

Examples

.LIB models.lib nom

.LIB 'models.lib' low

.LIB "models.lib" low

.LIB "path/models.lib" high
```

# Arguments and Options

file name

Name of file containing netlist data. Single or double quotes (" or ') may be used around the file name.

entry name

Entry name, which determines the section of the file to be included. These sections are defined in the included file using the definition form of the . LIB statement.

The library file name can be surrounded by quotes (single or double), as in "path/filename" but this is not necessary. The directory for the library file is assumed to be the execution directory unless a full or relative path is given as a part of the file name. The section name denotes the section or sections of the library file to include.

If <file name> uses an absolute path then that path is used. Otherwise, the search-path order for <file name> is:

- Relative to the directory that contains <file name>.
- Relative to the directory that contains the file with the top-level netlist.
- Relative to the Xyce execution directory.

## 2.1.16.2. .LIB definition statement

The format given above is when the .LIB command is used to reference a library file; however, it is also used as part of the syntax in a library file.

# **General Form**

```
.LIB <entry name>
<netlist lines>*
.endl <entry name>
```

# **Examples**

```
* Library file res.lib
.lib low
.param rval=2
r3 2 0 9
.endl low
.lib nom
.param rval=3
r3 2 0 8
.endl nom
```

# Arguments and Options

entry name

The name to be used to identify this library component. When used on a .  $\mbox{LIB}$  call line, these segments of the library file will be included in the calling file.

Note that for each entry name, there is a matched .lib and .endl. Any valid netlist commands can be placed inside the .lib and .endl statements. The following is an example calling netlist, which refers to the library in the examples above:

```
* Netlist file res.cir
V1 1 0 1
R 1 2 {rval}
.lib res.lib nom
.tran 1 ps 1ns
.end
```

In this example, only the netlist commands that are inside of the "nom" library will be parsed, while the commands inside of the "low" library will be discarded. As a result, the value for resistor r3 is 8, and the value for rval is 3.

# 2.1.17. . LIN (Linear Analysis)

Extracts linear transfer parameters (S-, Y- and Z-parameters) for a general multiport network. Those parameters can be output in either Touchstone format [7].

### **General Form**

- .LIN [SPARCALC=<1|0>] [FORMAT=<TOUCHSTONE2|TOUCHSTONE>]
- + [LINTYPE=<S|Y|Z>] [DATAFORMAT=<RI|MA|DB>]
- + [FILE=<output filename>] [WIDTH=<print field width>]
- + [PRECISION=<floating point output precision>]

# **Examples**

- .LIN
- .LIN FORMAT=TOUCHSTONE DATAFORMAT=MA FILE=foo

# Arguments and Options

SPARCALC=<1|0>

If this is set to 1 then the LIN analysis is done at the frequency values specified on the .AC line. The default value is 1.

FORMAT=<TOUCHSTONE2 | TOUCHSTONE>

Output file format

TOUCHSTONE Output file is in Touchstone 1 format

TOUCHSTONE2 Output file is in Touchstone 2 format. The default is TOUCHSTONE2.

LINTYPE=<S|Y|Z>

The type of parameter data (S, Y or Z) in the output file. The default is S.

DATAFORMAT=<RI | MA | DB>

Format for the S-, Y- or Z-parameter data

RI Real-imaginary format

The data is output as the real and imaginary parts for each extracted S-, Y- or Z-parameter. This is the default.

MA Magnitude-angle format

The data is output as the magnitude and the phase angle of each extracted S-, Y- or Z-parameter. For compatibility with Touchstone formats, the angle values are in degrees.

DB Magnitude(dB)-angle format

The data is output as the magnitude (in dB) and the phase angle of each extracted S-, Y- or Z-parameter. For compatibility with Touchstone formats, the angle values are in degrees.

FILE=<output filename>

Specifies the name of the file to which the output will be written. For HSPICE compatibility FILENAME= is an allowed synonym for FILE= on . LIN lines.

WIDTH=<print field width>

Controls the output width used in formatting the output.

PRECISION=<floating point precision>

Number of floating point digits past the decimal for output data.

#### Comments

The .LIN command line functions like a .PRINT line for the extracted S-, Y- or Z-parameter data. So, a netlist can have multiple .LIN lines with different values for the LINTYPE, DATAFORMAT and FILE arguments on each line. If there are multiple .LIN lines in the netlist, then a linear analysis will be performed if SPARCALC=1 on any of those .LIN lines.

The default filename for both Touchstone formats is <netlistName>.sNp where N is the number of "ports" (P devices) specified in the netlist.

The Xyce Touchstone output is based on the Touchstone standard [7]. So, it differs slightly from the corresponding HSPICE output. In particular, the full matrix of S-, Y- or Z-parameters is always output.

The HSPICE SPARDIGIT and FREQDIGIT arguments are not supported. Instead, the PRECISION argument is used for all of the output values.

The output of individual S-parameters via the .PRINT AC line is supported.

If the -r < raw-file-name > and -a command line options are used with .LIN with SPARCALC=1 then Xyce will exit with a parsing error.

The  $-\circ$  command line option can be used with .LIN. In that case, the output defaults to Touchstone 2 format and any FILE=<filename> argument on the .LIN line is ignored.

# 2.1.18. . MEASURE or . MEAS (Measure output)

The .MEASURE statement allows calculation or reporting of simulation metrics to an external file, as well as to the standard output and/or a log file. One can measure when simulated signals reach designated values, or when they are equal to other simulation values. The .MEASURE statement is supported for .TRAN, .DC, .AC and .NOISE analyses. It can be used with .STEP in all four cases. For HSPICE compatibility, .MEAS is an allowed synonym for .MEASURE.

The syntaxes for the .MEASURE statements are shown below. The AVG, DERIV, EQN, ERR, ERR1, ERR2, FIND-AT, FIND-WHEN, INTEG, MIN, MAX, PP, RMS and WHEN measures are supported for all four "measure modes" (TRAN, AC, DC and NOISE). The TRIG-TARG measure is only supported for TRAN measure mode. Note that each measure type (e.g., MAX) may be listed twice. This is because only a subset of the allowed "qualifiers" (e.g., FROM and TO) may be supported for the AC, DC and NOISE measure modes.

The ERROR measure is Xyce-specific, and is supported for TRAN, AC, DC and NOISE measure modes. The DUTY, FREQ, FOUR, OFF\_TIME and ON\_TIME measures are also Xyce-specific, and are only supported for TRAN measure mode.

#### **General Form**

```
.MEASURE TRAN <result name> AVG <variable>
+ [MIN THRESH=<value>] [MAX THRESH=<value>]
+ [FROM=<time>] [TO=<time>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> DERIV <variable> AT=<value>
+ [MINVAL=<value>] [DEFAULT_VAL=<value>]
+ [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> DERIV <variable>
+ WHEN <variable>=<variable2>|<value>
+ [MINVAL=<value>] [FROM=<value>] [TO=<value>] [TD=<value>]
+ [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> DUTY <variable>
+ [ON=<value>] [OFF=<value>] [MINVAL=<value>]
+ [FROM=<value>] [TO=<value>] [TD=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> EQN <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> <ERR|ERR1|ERR2>
+ <variable<sub>1</sub>> <variable<sub>2</sub>> [FROM=<value>] [TO=<value>]
+ [MINVAL=<value>] [IGNOR|YMIN=<value>] [YMAX=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> ERROR <variable> FILE=<value>
```

```
+ INDEPVARCOL=<value> DEPVARCOL=<value> [COMP_FUNCTION=<value>]
```

- + [DEFAULT\_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
- .MEASURE TRAN <result name> FIND <variable> AT=<value>
- + [MINVAL=<value>] [DEFAULT\_VAL=<value>]
- + [PRECISION=<value>] [PRINT=<value>]

#### .MEASURE TRAN <result name> FIND <variable>

- + WHEN <variable>=<variable<sub>2</sub>>|<value>
- + [FROM=<value>] [TO=<value>]
- + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
- + [MINVAL=<value>] [DEFAULT\_VAL=<value>]
- + [PRECISION=<value>] [PRINT=<value>]

# .MEASURE TRAN <result name> FOUR <variable> AT=freq

- + [NUMFREQ=<value>] [GRIDSIZE=<value>]
- + [FROM=<value>] [TO=<value>] [TD=<value>]
- + [DEFAULT\_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]

### .MEASURE TRAN <result name> FREQ <variable>

- + [ON=<value>] [OFF=<value>] [MINVAL=<value>]
- + [FROM=<value>] [TO=<value>]
- + [DEFAULT\_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]

## .MEASURE TRAN <result name> INTEG <variable>

- + [FROM=<value>] [TO=<value>] [TD=<value>]
- + [DEFAULT\_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]

## .MEASURE TRAN <result name> MAX <variable>

- + [FROM=<value>] [TO=<value>] [TD=<value>]
- + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST] [RFC\_LEVEL=<value>]
- + [DEFAULT\_VAL=<value>] [PRECISION=<value>]
- + [PRINT=<value>] [OUTPUT=<value>]

# .MEASURE TRAN <result name> MIN <variable>

- + [FROM=<value>] [TO=<value>] [TD=<value>]
- + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST] [RFC LEVEL=<value>]
- + [DEFAULT\_VAL=<value>] [PRECISION=<value>]
- + [PRINT=<value>] [OUTPUT=<value>]

# .MEASURE TRAN <result name> OFF\_TIME <variable>

- + [OFF=<value>] [MINVAL=<value>]
- + [FROM=<value>] [TO=<value>] [TD=<value>]
- + [DEFAULT\_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]

#### .MEASURE TRAN <result name> ON\_TIME <variable>

- + [ON=<value>] [MINVAL=<value>]
- + [FROM=<value>] [TO=<value>] [TD=<value>]

```
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> PP <variable>
+ [FROM=<value>] [TO=<value>]
+ [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST] [RFC LEVEL=<value>]
+ [DEFAULT VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> RMS <variable>
+ [FROM=<value>] [TO=<value>] [TD=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> WHEN <variable>=<variable2>|<value>
+ [FROM=<value>] [TO=<value>]
+ [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
+ [MINVAL=<value>] [DEFAULT_VAL=<value>]
+ [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> TRIG <variable>=<variable2>|<value>
+ [RISE=r1|LAST] [FALL=f1|LAST] [CROSS=c1|LAST]
+ TARG <variable<sub>3</sub>>=<variable<sub>4</sub>>|<value>
+ [RISE=r2|LAST] [FALL=f2|LAST] [CROSS=c2|LAST]
+ [FROM=<value>] [TO=<value>] [TD=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE TRAN <result name> TRIG AT=<value>
+ TARG <variable<sub>2</sub>>=<variable<sub>3</sub>>|<value>
+ [RISE=r2|LAST] [FALL=f2|LAST] [CROSS=c2|LAST]
+ [FROM=<value>] [TO=<value>] [TD=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> AVG <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> DERIV <variable> AT=<value>
+ [MINVAL=<value>] [DEFAULT VAL=<value>]
+ [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> DERIV <variable>
+ WHEN <variable>=<variable<sub>2</sub>>|<value>
+ [MINVAL=<value>] [FROM=<value>] [TO=<value>]
+ [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> EQN <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
```

```
.MEASURE <AC|DC|NOISE> <result name> <ERR|ERR1|ERR2>
+ <variable<sub>1</sub>> <variable<sub>2</sub>> [FROM=<value>] [TO=<value>]
+ [MINVAL=<value>] [IGNOR|YMIN=<value>] [YMAX=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> ERROR <variable>
+ FILE=<value> [DEPVARCOL=<value>] [COMP FUNCTION=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> FIND <variable> AT=<value>
+ [MINVAL=<value>] [DEFAULT_VAL=<value>]
+ [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> FIND <variable>
+ WHEN <variable>=<variable2>|<value>
+ [FROM=<value>] [TO=<value>]
+ [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
+ [MINVAL=<value>] [DEFAULT_VAL=<value>]
+ [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> INTEG <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> MAX <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>]
+ [PRINT=<value>] [OUTPUT=<value>]
.MEASURE <AC|DC|NOISE> <result name> MIN <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>]
+ [PRINT=<value>] [OUTPUT=<value>]
.MEASURE <AC|DC|NOISE> <result name> PP <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE <AC|DC|NOISE> <result name> RMS <variable>
+ [FROM=<value>] [TO=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
MEASURE <AC|DC|NOISE> <result name>
+ WHEN <variable>=<variable>>|<value>
+ [FROM=<value>] [TO=<value>]
+ [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
+ [MINVAL=<value>] [DEFAULT_VAL=<value>]
```

+ [PRECISION=<value>] [PRINT=<value>]

# **Examples**

```
.MEASURE TRAN hit1_75 WHEN V(1)=0.75 MINVAL=0.02
.MEASURE TRAN hit2_75 WHEN V(1)=0.75 MINVAL=0.08 RISE=2
.MEASURE TRAN avgAll AVG V(1)
.MEASURE TRAN dutyAll DUTY V(1) ON=0.75 OFF=0.25
.MEASURE DC maxV1 MAX V(1)
.MEAS DC minV2 MIN V(2)
.MEASURE AC maxV1R MAX VR(1)
.MEASURE NOISE maxonoise MAX ONOISE
```

# Arguments and Options

#### result name

Measured results are reported to the output and log file. Additionally, for TRAN measures, the results are stored in files called circuitFileName.mt#, where the suffixed number (#) starts at 0 and increases for multiple iterations (.STEP iterations) of a given simulation. Each line of this file will contain the measurement name, <result name>, followed by its value for that run. The <result name> must be a legal Xyce character string. For DC measures, the results are stored in the files circuitFileName.ms#, while AC and NOISE measures use the files circuitFileName.ma#.

If multiple measures are defined with the same <result name> then Xyce uses the last such definition, and issues warning messages about (and discards) any previous measure definitions with the same <result name>.

## measure type

```
AVG, DERIV, DUTY, EQN, ERR, ERR1, ERR2, ERROR, FIND, FREQ, FOUR, INTEG, MAX, MIN, OFF_TIME, ON_TIME, PP, RMS, WHEN, TRIG, TARG
```

The third argument specifies the type of measurement or calculation to be done. The only exception is the TARG clause which comes later in the argument list, after the TRIG clause has been specified.

By default, the measurement is performed over the entire simulation. The calculations can be limited to a specific measurement window by using the qualifiers FROM, TO, TD, RISE, FALL, CROSS and MINVAL, which are explained below.

The supported measure types and their definitions are:

AVG Computes the arithmetic mean of <variable> for the simulation, or within the extent of the measurement window. The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures, and with FROM and TO for AC, DC and NOISE measures.

DERIV Computes the derivative of <variable> at a user-specified time (by using the AT qualifier) or when a user-specified condition occurs

- (by using the WHEN qualifier). If the WHEN qualifier is used then the measurement window can be limited with the qualifiers FROM, TO, RISE, FALL and CROSS for all measure modes. In addition, the TD qualifier is supported for TRAN measures. The MINVAL qualifier is used as a comparison tolerance for both AT and WHEN. For HSPICE compatibility, DERIVATIVE is an allowed synonym for DERIV.
- DUTY Fraction of time that <variable> is greater than ON and does not fall below OFF either for the entire simulation, or the measurement window. The qualifier MINVAL is used as a tolerance on the ON and OFF values, so that the thresholds become (ON MINVAL) and (OFF MINVAL). The measurement window can be limited with the qualifiers FROM, TO, and TD for TRAN measures.
- EQN Calculates the value of <variable> during the simulation. The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures, and with FROM and TO for AC, DC and NOISE measures. As noted in the "Additional Examples" subsection, the variable can use the results of other measure statements.
- ERRX Calculates the error between two simulation variables, where the ERR1 and ERR2 functions (and the use of the MINVAL, YMIN and YMAX qualifiers in those functions) are defined further in the "Error Functions (ERR1 and ERR2)" subsection. The ERR measure type is a synonym for the ERR1 measure type. The measurement window can be limited with the qualifiers FROM and TO.
- ERROR Calculates the norm between the measured waveform and a "comparison waveform" specified in a file. The supported norms are L1, L2 and INFNORM. The default norm is the L2 norm.
- FIND-AT Returns the value of <variable> at the time when the AT clause is satisfied. The AT clause is described in more detail later in this list.
- FIND-WHEN Returns the value of <variable> at the time when the WHEN clause is satisfied. The WHEN clause is described in more detail later in this list.
- FOUR Calculates the fourier transform of the transient waveform for <variable>, given the fundamental frequency AT. All frequencies output by the measure will be multiples of that fundamental frequency, and will always start at that fundamental frequency. The values of the DC component and the first NUMFREQ-1 harmonics are determined using an interpolation of GRIDSIZE points. The default values for NUMFREQ and GRIDSIZE are 10 and 200, respectively. The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures. For this measure, the phase data is always output in degrees.
- FREQ An estimate of the frequency of <variable>, found by cycle counting during the simulation. Cycles are defined through the values of ON and OFF with MINVAL being used as a tolerance so that the

- thresholds becomes (ON MINVAL) and (OFF + MINVAL). The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures.
- INTEG Calculates the integral of outVal through second order numerical integration. The integration window can be limited with the qualifiers FROM, TO and TD for TRAN measures, and with FROM and TO for AC, DC and NOISE measures. For HSPICE compatibility, INTEGRAL is an allowed synonym for INTEG.
- MAX Returns the maximum value of <variable> during the simulation.

  The measurement window can be limited with the qualifiers FROM, TO,

  TD, RISE, FALL and CROSS for TRAN measures, and with FROM and

  TO for AC, DC and NOISE measures.
- MIN Returns the minimum value of <variable> during the simulation.

  The measurement window can be limited with the qualifiers FROM, TO,

  TD, RISE, FALL and CROSS for TRAN measures, and with FROM and

  TO for AC, DC and NOISE measures.
- OFF\_TIME Returns the time that <variable> is below OFF during the simulation or measurement window, normalized by the number of cycles of the waveform during the simulation or measurement window. OFF uses MINVAL as a tolerance, and the threshold becomes (OFF + MINVAL). The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures.
- ON\_TIME Returns the time that <variable> is above ON during the simulation or measurement window, normalized by the number of cycles of the waveform during the simulation or measurement window.

  ON uses MINVAL as a tolerance, and the threshold becomes (ON MINVAL). The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures.
- PP Returns the difference between the maximum value and the minimum value variable> during the simulation. The measurement window can be limited with the qualifiers FROM, TO, TD, RISE, FALL and CROSS for TRAN measures, and with FROM and TO for AC, DC and NOISE measures.
- RMS Computes the root-mean-squared value of <variable> during the simulation, which is defined as "the square root of the area under the <variable> curve, divided by the period of interest". The measurement window can be limited with the qualifiers FROM, TO and TD for TRAN measures, and with FROM and TO for AC, DC and NOISE measures.

TRIC

TARG Measures the time between a trigger event and a target event. The trigger is specified with TRIG <variable>=<variable2> or TRIG <variable>=<value> or TRIG AT=<value>. Likewise, the the target is specified as TARG <variable3>=<variable4> or TRIG <variable3>=<value>. It is also possible to use this

measure to find a rise time for variable when the rise time is defined as the time to go from some small fraction of the maxima to some other fraction of the maxima. For example, the syntax for finding a rise time from 10% to 90% of the maxima is:

```
TRIG V(node) FRAC_MAX=0.1 TARG V(node)
FRAC MAX=0.9
```

variable  $variable_n$  value

These quantities represents the test for the stated measurement. <variable> is a simulation quantity, such as a voltage or current. One can compare it to another simulation variable or a fixed quantity. Additionally, the <variable> may be a Xyce expression delimited by { } brackets. As noted above, an example is V(1) = 0.75

# AT=value

A time *at which* the measurement calculation will occur. This is used by the DERIV and FIND measures and the TRIG clause. Note that ill-considered use of the FROM, TO, TD and AT qualifiers in the same TRIG-TARG measure statement can cause an empty measurement window, and thus a failed measure. Finally, the FROM and TO qualifiers take precedence over the AT qualifier for DERIV and FIND measures.

#### FROM=value

A time (or frequency or DC sweep value) *after which* the measurement calculation will start. For DC measures, this qualifier uses the first variable on the .DC line.

#### TO=value

A time (or frequency or DC sweep value) *at which* the measurement calculation will stop. For DC measures, this qualifier uses the first variable on the .DC line.

# TD=value

A time delay before which this measurement should be taken or checked. Note that ill-considered use of both FROM and TO qualifiers and a TD

qualifier in the same measure statement can cause an empty measurement window, and thus a failed measure.

## MIN THRESH=value

A minimum threshold value above which the measurement calculation will be done and below which it will not be done. This is only used by the AVG measure.

#### MAX THRESH=value

A maximum threshold value above which the measurement calculation will not be done and below which it will be done. This is only used by the AVG measure.

#### RISE=r|LAST

The number of rises after which the measurement should be checked. If LAST is specified, then the last rise found in the simulation will be used. It is recommended that only one of the qualifiers RISE, FALL or CROSS be used in a given measure statement. The exception is TRIG-TARG measures. In that case, different RISE, FALL and CROSS criteria can be specified for TRIG and TARG.

## FALL=f|LAST

The number of falls after which the measurement should be checked. If LAST is specified, then the last fall found in the simulation will be used.

#### CROSS=c|LAST

The number of zero crossings after which the measurement should be checked. If LAST is specified, then the last zero crossing found in the simulation will be used.

#### RFC LEVEL=value

The level used to calculate rises, falls and crosses when the "level-crossing" mode is used by measure types that do not support the WHEN qualifier. So, RFC\_LEVEL is used by the MAX, MIN and PP measures. Its usage is discussed further in the subsection on "Rise, Fall and Cross Qualifiers".

# MINVAL=value

For the DERIV, DUTY, FIND, FREQ, OFF\_TIME, ON\_TIME and WHEN measures, this is allowed difference between outVal and the variable to which it is being compared. This has a default value of 1.0e-12. One may need to specify a larger value to avoid missing the test condition in a transient run. The descriptions of those seven measures detail how MINVAL is used by each measure. For the ERR1 and ERR2 measures, if the absolute value of <variable1> is less than MINVAL, then MINVAL replaces the value of the denominator of the ERR1 or ERR2 expression. For all measure types, that support the FROM, TO and/or TD qualifiers, MINVAL also functions as a relative tolerance for the comparison of the simulation time (or sweep value) to the bounds of the measurement window. This allows for numerical-roundoff errors if the FROM, TO and/or TD qualifiers are expressions.

#### YMIN=value

If the absolute value of <variable<sub>1</sub>> in ERR1 or ERR2 measure is less than the YMIN value then the ERR1 or ERR2 calculation does not consider that point. The default is 1.0e-15. IGNOR and IGNORE are synonyms for YMIN.

## YMAX=value

If the absolute value of <variable<sub>1</sub>> in ERR1 or ERR2 measure is greater than YMAX value then the ERR1 or ERR2 calculation does not consider that point. The default is 1.0e15.

## FRAC\_MAX=value

A fractional value of the maximum value of <variable>. This is useful for ensemble runs where the maximum value of a waveform is not known in advance. FRAC\_MAX is used by the TRIG and TARG measures.

#### ON=value

The value at which a signal is considered to be "on" for FREQ, DUTY and  $ON\_TIME$  measure calculations. This has a default value of 0.

# OFF=value

The value at which a signal is considered to be "off" for FREQ, DUTY and  $ON\_TIME$  measure calculations. This has a default value of 0.

#### DEFAULT VAL=value

If the conditions specified for finding a given value are not found during the simulation then the measure will return the default value of -1 in the circuitFileName.mt# (or circuitFileName.ms# or circuitFileName.ma#) files. The measure value in the standard output or log file will be FAILED. The default return value for the circuitFileName.mt# (or circuitFileName.ms# or circuitFileName.ma#) files is settable by the user for each measure by adding the qualifier <code>DEFAULT\_VAL=<retval></code> on that measure line. As examples, a measure will fail if the condition specified by a WHEN or AT qualifier is not found. It will also fail if the user specifies a set of FROM, TO and TD values for a given measure that yields an empty measurement interval. If either .OPTIONS MEASURE MEASFAIL=<val> or .OPTIONS MEASURE DEFAULT VAL=<val> are given in the netlist then those values override the DEFAULT\_VAL parameters given on individual . MEASURE lines. See Section 2.1.25 for more details. As a final note, the FOUR measure is a special case since it produces multiline output. Failed FOUR measures will be reported as FAILED in the circuitFileName.mt#(orcircuitFileName.ms#or circuitFileName.ma#) files, irrespective of the various MEASFAIL and DEFAULT VAL settings.

#### PRECISION=value

The default precision for .MEASURE output is 6 digits after the decimal point. This argument provides a user configurable precision for a given .MEASURE statement that applies to both the .mt# (or .ms# or .ma#) files and standard output. If .OPTIONS MEASURE MEASDGT=<val> is

given in the netlist then that value overrides the PRECISION parameters given on individual .MEASURE lines.

#### PRINT=value

This parameter controls where the .MEASURE output appears. The default is ALL, which produces measure output in both the .mt# (or .ms# or .ma#) file and to the standard output. A value of STDOUT only produces measure output to standard output, while a value of NONE suppresses the measure output to both the .mt# (or .ms# or .ma#) file and standard output. The subsection on "Suppressing Measure Output" gives examples and also discuss the interactions of this parameter with .OPTIONS MEASURE MEASPRINT=<val>.

## OUTPUT=value

This parameter is only supported for the MAX and MIN measures. The default is VALUE. For TRAN measures, a value of VALUE will print the maximum (or minimum) value to the .mt# file. A value of TIME will print the time of the maximum (or minimum) value to the .mt# file. For DC measures, a value of SV will output the value of the first variable on the .DC line to the .ms# file. For AC and NOISE measures, a value of FREQ will print the frequency at which the maximum (or minimum) value occurs to the .ma# file. This parameter does not affect the descriptive output that is printed to the standard output. The "Additional Examples" subsection gives an example for the MAX measure.

# VAL=value

This parameter is only implemented for the TRIG and TARG measures. It is not the preferred Xyce syntax. It is only supported for HSPICE compatibility (see that subsection, below, for details).

# GOAL=value

This parameter is not implemented in Xyce, but is included for compatibility with HSPICE netlists.

# WEIGHT=value

This parameter is not implemented in Xyce, but is included for compatibility with HSPICE netlists.

#### FILE=value

The filename for the "comparison file" used for the ERROR measure. This qualifier is required for the ERROR measure.

# INDEPVARCOL=value

The column index, in the "comparison file", of the independent variable (e.g, the simulation time or frequency) used in an ERROR measure. This qualifier is required for the TRAN, AC and NOISE measure modes. For those modes, the INDEPVARCOL and DEPVARCOL qualifiers must have different values. The INDEPVARCOL qualifier is not used for DC mode ERROR measures, and will be "silently ignored" in that case. Finally, note that the column indices in Xyce output files start with 0.

```
DEPVARCOL=value
```

The column index, in the "comparison file", of the dependent variable used in an ERROR measure. This qualifier is required for the ERROR measure for all four measure modes (TRAN, AC, DC and NOISE). For the TRAN, AC and NOISE measure modes, the DEPVARCOL and INDEPVARCOL qualifiers must have different values. Finally, note that the column indices in Xyce output files start with 0.

```
COMP FUNCTION=value
```

This is the norm used by the ERROR measure to compare the simulation values for the measured variable with the corresponding values in the "comparison file" specified with the FILE qualifier. The allowed values are L1NORM, L2NORM and INFNORM. Any other values will default to L2NORM. This qualifier is optional for the ERROR measure, and has a default value of L2NORM. The descriptive output for each ERROR measure, that is printed to standard output, will explicitly state which norm was used for each ERROR measure.

## 2.1.18.1. Measure Output

As previously mentioned, measured results are reported to the output and log file. Additionally, for TRAN measures, the results are stored in files called circuitFileName.mt#, where the suffixed number (#) starts at 0 and increases for multiple iterations (.STEP iterations) of a given simulation. For DC measures, the results are stored in the files circuitFileName.ms#, while AC and NOISE measures use the files circuitFileName.ma#.

A user-defined measure can also be output at each time-step via inclusion in a .PRINT command. For example, this netlist excerpt outputs the integral of V(1) at each time step. The measure value TINTV1 is then also output at the end of the simulation to both the standard output and the .mt# (or .ms# or .ma#) files.

```
.MEASURE TRAN TINTV1 INTEG V(1)
.PRINT TRAN FORMAT=NOINDEX V(1) TINTV1
```

The output for successful and failed measures to the standard output (and log files) provides more information than just the measure's calculated values. As an example, for a successful and failed MAX measure the standard output would be:

```
MAXVAL = 0.999758 at time = 0.000249037

Measure Start Time= 0 Measure End Time= 0.001

Netlist warning: MAXFAIL failed. TO value < FROM value

MAXFAIL = FAILED at time = 0

Measure Start Time= 1 Measure End Time= 0.001
```

In general, information on the measurement window, the time(s) that the measure's value(s) were calculated and a possible cause for a failed measure are output to standard output for all measures except

for FOUR. This information is similar, but not identical, to HSPICE's verbose output. For a failed FOUR measure, the standard output will have "FAILED", but there may be less information provided as to why the FOUR measure failed.

In this example, the circuitFileName.mt# file would have the following output:

```
MAXVAL = 0.999758
MAXFAIL = -1
```

#### 2.1.18.2. Measurement Windows

There is an implicit precedence when multiple qualifiers are specified to limit the measurement window for a given .MEASURE statement for TRAN measures. In general, Xyce first considers the time-window criteria of the FROM, TO and TD qualifiers. If the simulation time is within that user-specified time-window then the RISE, FALL, CROSS are qualifiers are counted and/or the TRIG, TARG and WHEN qualifiers are evaluated.

The following netlist excerpt shows simple examples where the .MEASURE statement may return the default value because the measure "failed". For riseSine, this may occur because V (1) never has an output value of 1.0 because of the time steps chosen by Xyce. So, careful selection of the threshold values in WHEN, TRIG and TARG clauses may be needed in some cases. For fallPulseFracMax, the simulation interval is too short and the TARG value of 0.3 for V(2) is not reached within the specified one-second simulation time. For maxSine, the FROM, TO and TD values yield an empty time interval, which is typically an error in netlist entry.

```
VS 1 0 SIN(0 1.0 0.5 0 0)

VP 2 0 PULSE( 0 10 0.2 0.2 0.2 0.5 2)

R1 1 0 100K

R2 2 0 100K

.TRAN 0 1

.PRINT TRAN FORMAT=NOINDEX V(1) V(2)

.MEASURE TRAN riseSine TRIG V(1)=0 TARG V(1)=1.0

.MEASURE TRAN fallPulseFracMax TRIG V(2) FRAC_MAX=0.97

+ TARG V(2) FRAC_MAX=0.03

.MEASURE TRAN maxSine MAX V(1) FROM=0.2 TO=0.25 TD=0.5
```

The intent in Xyce is for the measurement window to be the intersection of the FROM-TO and TD windows, if both are specified. As noted above, the use of both FROM-TO and TD windows can lead to an empty measurement window. So, that usage is not recommended.

# 2.1.18.3. Expression Support

These measure "qualifiers" (TO, FROM, TD, RISE, FALL, CROSS, AT, OFF, ON, DEFAULT\_VAL and VAL) support expressions. The caveat is that the expression must evaluate to a constant at the time that each measure object is made. So, that expression can not depend on solution variables or lead currents. This limitation matches HSPICE. It also can not depend on a global parameter. Finally, it can not depend on another measure's value, which is an allowed syntax in HSPICE.

Simple examples of allowed syntaxes for qualifiers are as follows, where all three measures will get the same answer:

```
.PARAM t1=0.2
.PARAM t2=0.3
.MEASURE TRAN M1 PP V(1) FROM='0.1+0.2'
.MEASURE TRAN M2 PP V(1) FROM={0.1+t1}
.MEASURE TRAN M3 PP V(1) TO={t2}
```

Expressions should also work in FIND-WHEN, WHEN and TRIG-TARG measures. The preferred Xyce syntax with curly braces and the three legal HSPICE syntaxes for expressions should all work. However, note that the two HSPICE expression syntaxes shown below are only legal in Xyce . MEASURE statements.

```
.PARAM a1=0.1 .PARAM a2=0.7 .MEASURE TRAN M4 FIND V(2) WHEN V(1)={a1} .MEASURE TRAN M4PAR FIND V(2) WHEN V(1)=PAR('a1') ; HSPICE exp. syntax .MEASURE TRAN M4PAREN FIND V(2) WHEN V(1)=('a1') ; HSPICE exp. syntax .MEASURE TRAN M5 WHEN V(1)={a1} .MEASURE TRAN M6 TRIG \{v(1)-0.1\} VAL={a1} TARG \{v(1)-0.5\} VAL={a2}
```

#### 2.1.18.4. Re-Measure

Xyce can re-calculate (or re-measure) the values for .MEASURE and/or .FFT statements using existing Xyce output files. This is useful for tuning .MEASURE and/or .FFT statements to better capture response metrics for a circuit when the underlying simulation runtime is long. To use this functionality, add the command line argument -remeasure <file>, where <file> is a Xyce-generated .prn, .csv or .csd output file.

There are several important limitations with -remeasure:

- The data required by the .MEASURE and/or .FFT statements must have been output in the simulation output file. When using <code>-remeasure</code>, Xyce does not recalculate the full solution, but uses the data supplied in the output file instead. Thus, everything a .MEASURE and/or .FFT statement needs to calculate its results must be in the output file. So, the nodal voltages (e.g., node A), lead currents (e.g, for device R1) and branch currrents requested by the .MEASURE statements must have been used, at least once, on the .PRINT statement in the form of V (A), N (a) or I (R1). They can not only appear on the .PRINT line within an expression or a voltage-difference operator.
- Only voltage node values, lead currents and branch currents can be used in .MEASURE statements while using -remeasure. Power values will not be interpreted correctly during a re-measure operation. A work-around for that limitation is illustrated below.
- -remeasure only works with .tran or .dc analyses. However, it can be used with .STEP in both cases. It is not currently supported for .ac analyses.
- For .tran analyses, -remeasure works with .prn, .csv and .csd formatted output data. However, it might only work with .csv and .csd files generated by Xyce.

- For .dc analyses, -remeasure works with .prn and .csd formatted output data. However, it might only work with .csd files generated by Xyce.
- -remeasure will fail if the netlist has a .op statement that precedes the .tran or .dc statement. This can be fixed by either moving the .op statement or by temporarily commenting the .op statement out during -remeasure.

As an example in using -remeasure, consider a netlist called myCircuit.cir which had previously been run in Xyce and produced the output file myCircuit.cir.prn. One could run -remeasure with the following command:

```
Xyce -remeasure myCircuit.cir.prn myCircuit.cir
```

A work-around for re-measuring power values (e.g., for device R1) is to use this combination of .PRINT and .MEASURE lines in the netlist. As noted above, expressions will work with re-measure if all of the quantities used in the expression also appear outside of an expression on the .PRINT line.

```
R1 a b 1
.PRINT TRAN V(a) V(b) I(R1)
.MEASURE TRAN PR1B MAX {(V(a)-V(b))*I(R1)}
```

# 2.1.18.5. RISE, FALL and CROSS Qualifiers

The RISE, FALL and CROSS qualifiers are supported for more measures types, and in more ways, in Xyce than in HSPICE for TRAN meaures. This sections explains those differences and supplies some examples. One key difference is that Xyce supports two different "modes" for these qualifiers for TRAN meaures.

The first mode is "level-crossing", where the RISE, FALL and CROSS counts are incremented each time the measured signal (e.g., V(a)) crosses the user-specified level (termed crossVal here). If we define currentVal and lastVal as the current and previous values of V(a), and riseCount, fallCount and crossCount as the number of rises, falls and crosses that have occurred, then the pseudo-code for this mode is:

```
if ( (currentVal-crossVal >= 0.0) AND (lastVal-crossVal < 0.0) )
{
    riseCount++;
}
else if( (currentVal-crossVal) <= 0.0) AND (lastVal-crossVal > 0.0) )
{
    fallCount++;
}
```

For this mode, the <code>crossCount</code> is then incremented if either the <code>riseCount</code> or the fallCount was incremented. This mode should work identically to HSPICE for the <code>DERIV-WHEN</code>, <code>FIND-WHEN</code>, <code>WHEN</code> and <code>TRIG-TARG</code> measures.

The second mode is termed "absolute". In this mode, Xyce attempts to auto-detect whether the measured waveform has started a new rise or fall. However, the crossCount is still evaluated against a fixed

crossVal of 0. This mode may be useful for pulse waveforms with sharp rises and falls, where the waveform's maximum (or minimum) level is not exactly known in advance. It may not work well with noisy waveforms. If we define two Boolean variables isRising and isFalling then the pseudo-code for this mode is:

The following table shows which of these two modes are supported for which Xyce measures.

Table 2-2. RISE, FALL and CROSS Support in .MEASURE.

| Measure            | Level-Crossing   | Absolute                         |
|--------------------|--|----------------------------------|
| DERIV-WHEN         | The crossVal is set by the value of the WHEN clause                      | No                               |
| FIND-WHEN and WHEN | The crossVal is set by the value of the WHEN clause                      | No                               |
| MAX                | A fixed crossVal can be set with RFC_LEVEL                               | Default, if RFC_LEVEL is not set |
| MIN                | A fixed crossVal can be set with RFC_LEVEL                               | Default, if RFC_LEVEL is not set |
| PP                 | A fixed crossVal can be set with RFC_LEVEL                               | Default, if RFC_LEVEL is not set |
| TRIG and TARG      | The levels are set separately by the values in the TRIG and TARG clauses | If FRAC_MAX is used              |

As simple examples of these two modes for the MAX measure, consider the following netlist:

```
*examples of RFC modes

VPWL1 1 0 PWL(0 0 0.2 0.5 0.4 0 0.6 0.75 0.8 0 1.0 0.75 1.2 0.0)

R1 1 0 100

.TRAN 0 1.2s

.MEASURE TRAN MAX1 MAX V(1) RISE=1
```

```
.MEASURE TRAN MAX2 MAX V(1) RISE=1 RFC_LEVEL=0.6
.MEASURE TRAN MAX3 MAX V(1) FALL=1 RFC_LEVEL=0.5
.PRINT TRAN V(1) MAX1 MAX2 MAX3
.END
```

The descriptive output to standard output would then be:

The MAX1 measure uses the "absolute" mode, so the first rise begins with the very first time-step. The maximum value in that first rise interval for measure MAX1 then occurs at time=0.2s. The MAX2 measure uses the "level-crossing" mode with a user-specified RFC\_LEVEL of 0.6V. So, the first rise interval for the MAX2 measure begins at time=0.56s, and the maximum value in that first rise interval occurs at time=0.6s. The MAX3 measure illustrates an important point. A "fall" is not recorded for the MAX3 measure at t=0.2 seconds, but a "rise" (and "cross") would be recorded, since the value of V(1) is exactly equal to the user-specified RFC\_LEVEL. So, the first fall interval for measure MAX3 begins at time=0.67s, when V(1) first passes through the user-specified RFC\_LEVEL of 0.5V.

## 2.1.18.6. Additional Examples

Pulse width measurements in Xyce can be done as follows, based on this netlist excerpt. This may be useful for ensemble runs, where the maximum value of a one-shot pulse is not known in advance. The first syntax uses three measure statements to measure the 50% pulse width, and works with noisy waveforms. The second syntax uses only one measure statement, but may not always work with noisy waveforms.

```
* pulse-width measurement example 1
.measure tran rise50FracMax trig v(1) frac_max=0.5 targ v(1) frac_max=1
.measure tran fall50FracMax trig v(1) frac_max=1 targ v(1) frac_max=0.5
.measure tran 50width EQN{rise50FracMax + fall50FracMax}

* pulse-width measurement example 2
.measure tran 50widthFracMax trig v(1) frac_max=0.50 targ v(1) frac_max=0.50 FALL=1
```

In some cases, the user may wish to print out both the measure value and measure time (or the value of the first variable on the .DC line) of a MAX or MIN measure to the .mt0 file. For a TRAN measure, this can be done for these two measures with the OUTPUT keyword as follows:

```
* printing maximum value and time of maximum value to .mt0 file .TRAN 0 1  
V1 1 0 PWL 0 0 0.5 1 1 0  
R1 1 0 1  
.MEASURE TRAN MAXVAL MAX V(1)  
.MEASURE TRAN TIMEOFMAXVAL V(1) OUTPUT=TIME
```

The output to the .mt0 file would be:

```
MAXVAL = 1.000000e+00
TIMEOFMAXVAL = 5.000000e-01
```

The descriptive output to standard output would be the same for both measures though. The measure value and measure time are not re-ordered in the descriptive output when OUTPUT=VALUE is used for the MAX or MIN measures.

```
MAXVAL = 1.000000e+00 at time = 5.000000e-01

Measure Start Time= 0.000000e+00 Measure End Time= 1.000000e+00

TIMEOFMAXVAL = 1.000000e+00 at time = 5.000000e-01

Measure Start Time= 0.000000e+00 Measure End Time= 1.000000e+00
```

For a DC measure, one would use OUTPUT=SV instead of OUTPUT=TIME. In that case, the "sweep value" (SV) is the value of the first variable on the .DC line. For an AC or NOISE measure, one would use OUTPUT=FREQ.

# 2.1.18.7. Suppressing Measure Output

If the Xyce output is post-processed with other programs, such as Dakota, it may be desirable to only print a subset of the measure values to the .mt# (or .ms# or .ma#) files, but to print all of the measure output to standard output. As an example, these .MEASURE statements:

```
.TRAN 0 2ms
.measure tran minSineOne min V(1) print=none
.measure tran minSinTwo min V(2) print=stdout
.measure tran minSinThree min V(3) print=all
.measure tran sinSinFive min V(4)
```

would produce the following measure output in the .mt 0 file:

```
MINSINTHREE = -3.851422e-01
MINSINFOUR = -1.998548e+00
```

and the following measure output in standard output:

```
MINSINTWO = -1.188589e+00 at time = 7.400000e-04

Measure Start Time= 0.000000e+00 Measure End Time= 2.000000e-03

MINSINTHREE = -3.851422e-01 at time = 2.400000e-04

Measure Start Time= 0.000000e+00 Measure End Time= 2.000000e-03

MINSINFOUR = -1.998548e+00 at time = 7.500000e-04

Measure Start Time= 0.000000e+00 Measure End Time= 2.000000e-03
```

.OPTIONS MEASURE MEASPRINT=<val> also provides the option to accomplish these same effects, but for all of the measure statements in the netlist. The interactions between these two features are as follows. If MEASPRINT=ALL is used, which is the default setting, then the PRINT qualifier on a given .MEASURE line will override that setting. However, MEASPRINT=NONE and MEASPRINT=STDOUT will take precedence over the PRINT qualifiers on individual .MEASURE lines. Finally, the MEASPRINT option will be ignored during remeasure, but the PRINT qualifiers on individual measure lines will be used.

.OPTIONS MEASURE MEASOUT=<val> provides another way to suppress the output of the .mt# (or .ms# or .ma#) files. See Section 2.1.25 for more details. If given, this option takes precedence over the MEASPRINT option setting. However, it is also ignored during remeasure.

# 2.1.18.8. ERROR Functions (ERR1 and ERR2)

This subsection defines the calculation functions for the ERR1 and ERR2 measure types. For the ERR1 measure, the measure value is calculated as follows, where  $M_i$  and  $C_i$  are the first and second variables on the measure line and N is the number of time, frequency or DC sweep values included in the measure calculation:

$$ERR1 = \sqrt{\frac{1}{N} \sum_{i=1}^{N} \left( \frac{M_i - C_i}{max(MINVAL, |M_i|)} \right)^2}$$
(2.1)

For the ERR2 measure, the value is:

$$ERR2 = \frac{1}{N} \sum_{i=1}^{N} \left| \frac{M_i - C_i}{max(MINVAL, |M_i|)} \right|$$
 (2.2)

For both measures, if the absolute value of  $M_i$  is less than the YMIN value or greater than the YMAX value then the ERR1 or ERR2 calculation does not consider that point. The default for YMIN is 1.0-e15. The default for YMAX is 1.0e15.

# 2.1.18.9. ERROR Measure

The Xyce ERROR measure is not the functional equivalent of the ERR1 or ERR2 measures. It is intended to solve a different problem, namely the comparison of data in multiple simulation runs to an assumed "gold standard" read in from a file. It also uses different comparision functions then the ERR1 and ERR2 measures.. This subsection lists some important caveats with the use of the ERROR measure.

- The comparison file, specified with the FILE qualifier, can be .prn, .csv and .csd formatted output data. However, the ERROR measure might only work with .csv and .csd files generated by Xyce.
- The data in the comparison file is assumed to be "non-step data", from one simulation iteration. The simulated data can use .STEP though and the ERROR measure values will be re-evaluated for each step.
- For TRAN (or AC or NOISE) measures, the values of the measured waveform are interpolated to the simulation times (or frequencies) in the comparison waveform. So, the norm calculation is inherently windowed to the time (or frequency) interval of the comparison waveform. For the best interpolation results for AC or NOISE measures, it is recommended that the frequency extent of the comparison waveform be greater than or equal to the frequency extent of the measured waveforms.
- For DC measures, interpolation is not used. So, the values of the simulated and comparion waveforms are compared at the values specified by the DEPVARCOL qualifier. Any value for the INDEPVARCOL qualifier specified on a DC measure line will be "silently ignored".
- The time and frequency window constraints (TO, FROM and TD qualifiers) are not supported for the ERROR measure. So, as noted above, the effective window for the norm calculation is set by the extent of the comparison waveform.
- The values in the column in the comparison file specified with the INDEPVARCOL qualifier must be monotonically increasing for a TRAN, AC or NOISE measure. Otherwise, Xyce will not run the simulation.
- The ERROR measure currently supports the L1, L2 and INFNORM, with the default being the L2 norm. If anything other than L1, L2 or INFNORM is specified, Xyce will default to the L2 norm. The descriptive output for each ERROR measure, that is printed to standard output, will explicitly state which norm was used for each ERROR measure. (Note: The norm value is selected with the COMP\_FUNCTION qualifier, and the allowed values are L1NORM, L2NORM and INFNORM.)

As a final note, the ERROR measure can enable the use of Xyce simulation output in optimization problems, like device calibration. However, for internal Sandia users, there may be better approaches that leverage the combined capabilities of Sandia's Dakota and Xyce software packages.

# 2.1.18.10. Operator Support for AC Mode Measures

All of the operators supported on .PRINT AC lines are supported for AC measure mode. The linear parameter operators (e.g., SR(1,1)) are only supported when a .LIN analysis is done, but their values can be used in .MEASURE AC statements in that case.

One caveat is that AC mode measures that use V(a) will actually measure VR(a). The same caveat applies to the use of S(1,1). An AC mode measure would measure SR(1,1) instead.

# 2.1.18.11. Operator Support for NOISE Mode Measures

All of the operators supported on .PRINT NOISE lines are supported for NOISE measure mode. One caveat is that NOISE mode measures that use V(a) will actually measure VR(a).

# 2.1.18.12. Behavior for Unsupported Modes and Types

The .MEASURE statement is supported for .TRAN, .AC, .DC and .NOISE analyses. It can be used with .STEP in all four cases. So, Xyce does not support HB measure mode. If that mode is included in the netlist then Xyce parsing will fail and emit error messages. Similarly, Xyce parsing will fail if the requested measure type is not supported for a given measure mode (e.g., OFF\_TIME for a AC, DC or NOISE measure).

# 2.1.18.13. Compatibility with .DATA

The .DATA command can be used to specify table-based .AC, .DC or .NOISE sweeps for those three analysis types. For AC and NOISE measures, the "swept variable" then uses the frequency values in the table specified on the .AC or .NOISE line.

For DC measures, the swept variable uses the row index in the table specified on the .DC line. An example is as follows:

```
* example of .DATA with DC measures
V1 1 0 1
R1 1 2 1
R2 2 0 1
.data test
+ r1
               r2
+ 1.0e+00 4.0e+00
+ 4.0e+00 6.0e+00
+ 6.0e+00 4.0e+00
.enddata
.DC data=test
.print DC V(1) V(2)
.OPTIONS MEASURE MEASDGT=1
.MEASURE DC MAXV2TO MAX V(2) TO=2
.MEASURE DC MAXV2FROM MAX V(2) FROM=2
.END
```

The measure results reported in stdout will be as follows where the respective maximum values occur for the R1 and R2 values given in the first and second rows of the test table:

```
MAXV2TO = 8.0e-01 at Table Row value = 1.0e+00
Measure Start Table Row Value= 1.0e+00 Measure End Table Row Value= 2.0e+00
MAXV2FROM = 6.0e-01 at Table Row value = 2.0e+00
Measure Start Table Row Value= 2.0e+00 Measure End Table Row Value= 3.0e+00
```

All valid measure types will return an answer when a data-based sweep is used on the .AC, .DC or .NOISE line. However, the results for AVG, DERIV, FIND, INTEG, RMS and WHEN measures may be "non-physical" if the frequency values in the data table are not monotonically increasing. In addition, for DC measures the effective step size between table rows is equal to one.

# 2.1.18.14. HSPICE Compatibility

There are known incompatibilities between the Xyce and HSPICE implementation of <code>.MEASURE</code>. They include the following:

- Since .AC and .NOISE are separate analysis types in Xyce, there are separate AC and NOISE measure modes.
- Several of the Xyce measure types (DUTY, EQN, FREQ, FOUR, ON\_TIME, and OFF\_TIME) and qualifers (e.g., FRAC\_MAX) are not found in HSPICE. Several HSPICE measures are not supported in Xyce.
- The HSPICE qualifers of REVERSE and PREVIOUS are not supported in Xyce.
- The HSPICE . POWER statement, which prints out a table with the AVG, RMS, MIN and MAX measures for each specified signal, is not supported in Xyce.
- Xyce generally supports more qualifiers (FROM, TO, TD, RISE, FALL and CROSS) for the measurement windows for a given measure-type. So, some legal Xyce syntaxes may not be legal in HSPICE.
- For TRIG and TARG clauses in Xyce, the TD qualifier applies to both the TRIG and TARG qualifiers. HSPICE allows the specification of separate time-delays for the TRIG and TARG clauses.
- Xyce will not return a negative value from a TRIG and TARG measure. The TARG clause is only evaluated if the TRIG clause is satisfied. This behavior is different from HSPICE.
- The Xyce EQN measure can calculate an expression based on other measure values. So, one of its usages is similar to the HSPICE PARAM measure. However, their syntaxes are different.
- A mismatch between the measure mode and the analysis mode (e.g., a DC measure in a netlist that uses a .TRAN analysis statement) will cause a Xyce netlist parsing error. That same mismatch might be silently ignored by HSPICE.
- How Xyce and HSPICE handle "steps" may be different. In Xyce, the "steps" in the measured data (e.g., the generation of new .mt# or .ms# or .ma# files) are triggered by the variable(s) on the .STEP line, but not by the variable(s) on the .DC line.
- Expressions on .MEASURE lines are supported in fewer contexts then in HSPICE. See the "Expression Support" subsection for more details.
- The settings for the MEASFAIL and MEASOUT options are only used if those options are explicitly given in the netlist. Otherwise, the Xyce defaults will be used.

Additional syntax differences between TRIG and TARG clauses in Xyce and HSPICE are as follows. In HSPICE, a RISE, FALL or CROSS keyword must be specified in the following measure statement. Those RISE keywords are optional with this particular syntax example in Xyce. If they are omitted, then Xyce uses a default value of 1.

```
.measure tran riseSine trig v(1)=0.01 RISE=1 targ v(1)=0.99 RISE=1
```

The following HSPICE syntax (VAL=0.9) is supported in Xyce for TRIG and TARG measures. However, the preferred Xyce syntax would use targ v(1) = 0.9 instead.

```
.measure tran riseSine trig v(1) AT=0.0001 targ v(1) VAL=0.9 RISE=1
```

The remainder of this subsection discusses alternate syntaxes for Xyce measure lines that are supported for improved HSPICE compatibility. The definitions of the measure syntaxes given at the beginning of this . MEASURE section give the preferred Xyce syntaxes. However, PARAM (and the equivalent EQN) measure lines are allowed with, or without, the equal sign after the PARAM keyword. So, these two Xyce measure statements are equivalent:

```
.measure tran noEqualSgn PARAM \{v(1)+1.0\}
.measure tran equalSgn PARAM=\{v(1)+1.0\}
```

There are multiple expression syntaxes that are allowed in various contexts on HSPICE measure lines. So, all of these example syntaxes are allowed in expression contexts on Xyce measure lines. (Note: Only the first single-quote-delimited expression format is supported in all Xyce expression contexts, in addition to the Xyce curly-braces format.)

```
.measure tran curlyBraces MAX \{V(1)+1\}
.measure tran singleQuote MAX 'V(1)+1'
.measure tran parenSingleQuote MAX ('V(1)+1')
.measure tran parSyntax MAX PAR('V(1)+1')
```

Undelimited expressions are allowed in some contexts in HSPICE. However, the syntax for the notLegalInXyce measure shown below is not allowed in Xyce, since it uses an undelimited expression.

```
.measure tran PLUS PP PAR('V(1)+V(2)')
.measure tran notLegalInXyce PARAM PLUS+2.0; not legal
```

# 2.1.19. . MEASURE (Continuous results)

"Continuous" measure results are supported for DERIV-AT, DERIV-WHEN, FIND-AT, FIND-WHEN and WHEN measures, for .TRAN, .DC, .AC and .NOISE analyses. They are identical to the "non-continuous" versions, except that they can return more than one measured value in some cases. Continuous measure mode is not supported for TRIG or TARG measures.

```
.MEASURE <AC_CONT|DC_CONT|NOISE_CONT|TRAN_CONT> <result name>
General Form
              + DERIV <variable> AT=<value>
              + [MINVAL=<value>] [DEFAULT_VAL=<value>]
              + [PRECISION=<value>] [PRINT=<value>]
              .MEASURE TRAN_CONT <result name>
              + DERIV <variable> WHEN <variable>=<variable2>|<value>
              + [MINVAL=<value>] [FROM=<value>] [TO=<value>] [TD=<value>]
              + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
              + [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
              .MEASURE <AC_CONT|DC_CONT|NOISE_CONT> <result name>
              + DERIV <variable> WHEN <variable>=<variable<sub>2</sub>>|<value>
              + [MINVAL=<value>] [FROM=<value>] [TO=<value>]
              + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
              + [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
              .MEASURE <AC_CONT|DC_CONT|NOISE_CONT|TRAN_CONT> <result name>
              + FIND <variable> AT=<value>
              + [MINVAL=<value>] [DEFAULT_VAL=<value>]
              + [PRECISION=<value>] [PRINT=<value>]
              .MEASURE TRAN_CONT <result name>
              + FIND <variable> WHEN <variable>=<variable2>|<value>
              + [FROM=<value>] [TO=<value>] [TD=<value>]
              + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
              + [MINVAL=<value>] [DEFAULT_VAL=<value>]
              + [PRECISION=<value>] [PRINT=<value>]
              .MEASURE <AC_CONT|DC_CONT|NOISE_CONT> <result name>
              + FIND <variable> WHEN <variable>=<variable2>|<value>
              + [FROM=<value>] [TO=<value>]
              + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
              + [MINVAL=<value>] [DEFAULT_VAL=<value>]
              + [PRECISION=<value>] [PRINT=<value>]
              .MEASURE TRAN_CONT <result name>
              + WHEN <variable>=<variable2>|<value>
              + [FROM=<value>] [TO=<value>]
              + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
              + [MINVAL=<value>] [DEFAULT_VAL=<value>]
```

+ [PRECISION=<value>] [PRINT=<value>]

MEASURE <AC\_CONT|DC\_CONT|NOISE\_CONT> <result name>

- + WHEN <variable>=<variable2>|<value>
- + [FROM=<value>] [TO=<value>]
- + [RISE=r|LAST] [FALL=f|LAST] [CROSS=c|LAST]
- + [MINVAL=<value>] [DEFAULT\_VAL=<value>]
- + [PRECISION=<value>] [PRINT=<value>]

## **Examples**

```
.MEASURE TRAN_CONT DERIV1At5 DERIV V(1) AT=5
```

- .MEASURE DC\_CONT deriv2 DERIV WHEN V(2)=0.75
- .MEASURE AC\_CONT find1at5 FIND V(1) AT=5
- .MEASURE NOISE\_CONT find1 FIND V(1) WHEN V(2)=1 RISE=2
- .MEASURE TRAN\_CONT whenv1 WHEN V(1)=5

# Arguments and Options

result name

Measured results are reported to the log file and (possibly) multiple output files. Section 2.1.19.1 below gives more information on the output files produced by continuous mode measures.

The <result name> must be a legal Xyce character string. If multiple measures are defined with the same <result name> then Xyce uses the last such definition, and issues warning messages about (and discards) any previous measure definitions with the same <result name>.

```
measure type
DERIV, FIND, WHEN
```

The third argument specifies the type of measurement or calculation to be done.

By default, the measurement is performed over the entire simulation. The calculations can be limited to a specific measurement window by using the qualifiers FROM, TO, TD, RISE, FALL, CROSS and MINVAL, which are explained below and in section 2.1.18..

The supported "continuous" measure types and their definitions are:

DERIV Computes the derivative of <variable> at a user-specified time (by using the AT qualifier) or when a user-specified condition occurs (by using the WHEN qualifier). If the WHEN qualifier is used then the measurement window can be limited with the qualifiers FROM, TO, RISE, FALL and CROSS for all measure modes. In addition, the TD qualifier is supported for TRAN\_CONT measures. The MINVAL qualifier is used as a comparison tolerance for both AT and WHEN. For HSPICE compatibility, DERIVATIVE is an allowed synonym for DERIV.

FIND-AT Returns the value of <variable> at the time when the AT clause is satisfied. The AT clause is described in more detail later in this

list.

FIND-WHEN Returns the value of <variable> at the time when the WHEN clause is satisfied. The WHEN clause is described in more detail later in this list.

variable  $variable_n$  value

These quantities represents the test for the stated measurement. <variable> is a simulation quantity, such as a voltage or current. One can compare it to another simulation variable or a fixed quantity. Additionally, the <variable> may be a Xyce expression delimited by { } brackets. As noted above, an example is V(2) = 0.75

Additional information on the TO, FROM, TD, RISE, FALL, CROSS, MINVAL, DEFAUAL\_VAL, PRECISION and PRINT qualifiers is given in section 2.1.18.

## 2.1.19.1. Measure Output

As discussed in section 2.1.18.1, measured results for AC, DC, NOISE and TRAN mode measures are reported to the log file. Additionally, for TRAN measures, the results are stored in files called circuitFileName.mt#, where the suffixed number (#) starts at 0 and increases for multiple iterations (.STEP iterations) of a given simulation. For DC measures, the results are stored in the files circuitFileName.ms#, while AC and NOISE measures use the files circuitFileName.ma#.

For AC\_CONT, DC\_CONT, NOISE\_CONT and TRAN\_CONT mode measures, the output for successful and failed measures is sent to the standard output (and log files), as described in section 2.1.18.1. There are two options for the output files though. The default is for each continuous mode measure to generate its own output file where, for example for a non-step transient analysis, the file name would be circuitFileName\_resultname.mt0 where the result (measure) name is always output in lower-case. This default matches HSPICE. The second option uses .OPTIONS MEASURE USE\_CONT\_FILES=0. In that case, the results for all of the continuous mode measures are sent to the circuitFileName.mt# file.

An example is as follows.

```
VPWL1 1 0 pwl(0 0 2.5m 1 5m 0 7.5m 1 10m 0)
R1 1 0 1

.TRAN 0 10ms
.PRINT TRAN V(1)

.MEASURE TRAN MAXV1 MAX V(1)
.MEASURE TRAN_CONT FindV1 WHEN V(1)=0.5
.MEASURE TRAN_CONT FindV1AT FIND V(1) AT=0.6ms
.END
```

The result for measure MAXV1 is sent to <netlistName>.mt0. The results for measures FindV1 and FindV1AT are then sent to individual files, named <netlistName>\_findv1.mt0 and <netlistName>\_findv1at.mt0. Note that the measure names have been lower-cased in the output file names. The contents of those files are then as follows.

```
FINDV1 = 1.250000e-03

FINDV1 = 3.750000e-03

FINDV1 = 6.250000e-03

FINDV1 = 8.750000e-03

and:

FINDV1AT = 2.400000e-01
```

Note that FIND-AT measures will still only return one measure value, even for TRAN\_CONT measure mode. However, in this simple example, the specified FIND-WHEN measure returns all four times where V(1) equals 0.5. The next subsection will describe how the RISE, FALL and CROSS qualifiers can used to return only a subset of those four crossings.

## 2.1.19.2. RISE, FALL and CROSS Qualifiers

Xyce supports both positive and negative values for the RISE, FALL and CROSS qualifiers. However, their interpretation is slightly different for TRAN and TRAN\_CONT measure modes, as illustrated by the following netlist for the TRAN\_CONT measure mode and WHEN measure. The rules are then the same for the other continuous measures modes and the RISE and FALL qualifiers.

```
VPWL1 1 0 pwl(0 0 2.5m 1 5m 0 7.5m 1 10m 0)
R1 1 0 1

.TRAN 0 10ms
.PRINT TRAN V(1)
```

```
.MEASURE TRAN FindV1_CROSS3 WHEN V(1)=0.5 CROSS=3
.MEASURE TRAN_CONT FindV1_CONT_CROSS3 WHEN V(1)=0.5 CROSS=3
.MEASURE TRAN FindV1_CROSS_NEG3 WHEN V(1)=0.5 CROSS=-3
.MEASURE TRAN_CONT FindV1_CONT_CROSS_NEG3 WHEN V(1)=0.5 CROSS=-3
.END
```

The <netlistName>.mt0 file will contain the results for both TRAN mode measures. The result for the FindV1\_CROSS3 is the time of the third crossing. The result for the FindV1\_CROSS\_NEG3 is the time of the second crossing, which is also the "third to last" (or negative third) crossing in this case.

```
FINDV1_CROSS3 = 6.250000e-03
FINDV1_CROSS_NEG3 = 3.750000e-03
```

The <netlistName>\_findv1\_cont\_cross3.mt0 output file will have two values. For non-negative values of CROSS, a TRAN\_CONT measure will return all crossings, starting with the specified value. This is the third and fourth crossings in this case.

```
FINDV1_CONT_CROSS3 = 6.250000e-03
FINDV1_CONT_CROSS3 = 8.750000e-03
```

For negative values of CROSS, a TRAN\_CONT measure will only return one value. That is the third-to-last crossing in this case. So, the <netlistName>\_findv1\_cont\_cross3\_neg3.mt0 file only has one value in it. As a final note, a CROSS value of either 5 or -5 would produce failed measures in this example.

```
FINDV1 CONT CROSS NEG3 = 3.750000e-03
```

# 2.1.19.3. HSPICE Compatibility

There are known incompatibilities between the Xyce and HSPICE implementation of <code>.MEASURE</code>. They include the following:

• TBD

# 2.1.20. . MEASURE FFT (Measure output for .FFT)

The .MEASURE FFT statement allows calculation or reporting of simulation metrics, from data associated with .FFT analyses, to an external file as well as to the standard output and/or a log file, So, it is only supported for .TRAN, analyses. It can be used with .STEP. For HSPICE compatibility, .MEAS is an allowed synonym for .MEASURE.

The syntaxes for the .MEASURE FFT statements are shown below.

#### General Form

```
.MEASURE FFT <result name> ENOB <variable> [BINSIZ=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE FFT <result name> EQN <variable>
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE FFT <result name> FIND <variable> AT=<value>
+ [PRECISION=<value>] [PRINT=<value>]
.MEASURE FFT <result name> SFDR <variable>
+ [MINFREQ=<value>] [MAXFREQ=<value>] [BINSIZ=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE FFT <result name> SNDR <variable>
                                            [BINSIZ=<value>]
+ [DEFAULT VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE FFT <result name> SNR <variable> [MAXFREQ=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
.MEASURE FFT <result name> THD <variable>
+ [NBHARM=<value>] [MAXFREQ=<value>]
+ [DEFAULT_VAL=<value>] [PRECISION=<value>] [PRINT=<value>]
```

## **Examples**

```
.FFT V(1) NP=16

.MEASURE FFT ENOBVAL ENOB V(1)

.MEASURE FFT EQNVAL EQN VR1AT2

.MEASURE FFT VR1AT2 VR(1) AT=2

.MEASURE FFT SFDRVAL SFDR V(1)

.MEASURE FFT SNDRVAL SNDR V(1)

.MEASURE FFT SNRVAL SNR V(1)

.MEASURE FFT THDVAL THD V(1)
```

# Arguments and Options

result name

Measured results are reported to the output and log file. Additionally, the results are stored in files called circuitFileName.mt#, where the suffixed number (#) starts at 0 and increases for multiple iterations (.STEP

iterations) of a given simulation. Each line of this file will contain the measurement name, result name>, followed by its value for that run.
The result name> must be a legal Xyce character string.

If multiple measures are defined with the same <result name> then Xyce uses the last such definition, and issues warning messages about (and discards) any previous measure definitions with the same <result name>.

```
measure type
ENOB, EQN, FIND, SFDR, SNDR, SNR, THD
```

The third argument specifies the type of measurement or calculation to be done. By default, the measurement is performed over the time window defined by the START and STOP parameters on the associated .FFT line. So, the FROM, TO and TD qualifiers have no effect on FFT-based measures.

The supported measure types are:

- ENOB Calculates the "Effective Number of Bits", where that metric is defined in Section 2.1.8.3 which covers the .FFT command.
- EQN Calculates the value of <variable> during the simulation. That variable can use the results of other measure statements. PARAM is an allowed synonym for EQN as a measure type. For FFT measure mode, an EQN measure will be reported as "failed" until the associated FFT has been calculated.
- Examples of the mapping of Xyce operators (e.g., VM and IM) to FFT cofficients is given in the "Additional Examples" subsection below.

  FIND measures can be also used in conjunction with EQN measures to generate fairly arbitrary FFT-based measures. The FIND measure for FFT measure mode does not support expressions, or the P and W operators. It also does not support multi-terminal lead current operators, such as IC().
- SFDR Calculates the "Spurious Free Dynamic Range", where that metric is defined in Section 2.1.8.3.
- SNDR Calculates the "Signal to Noise-plus-Distortion Ratio", where that metric is defined in Section 2.1.8.3.
- SNR Calculates the "Signal to Noise Ratio", where that metric is defined in Section 2.1.8.3.
- THD Calculates the "Total Harmonic Distortion", where that metric is defined further below and also in in Section 2.1.8.3.

## variable

The <variable> is a simulation quantity, such as a voltage or current. Additionally, the <variable> may be a Xyce expression delimited by { } brackets. The only constraint is that the variable on the .MEASURE FFT line must be an exact match for the ov on at least one .FFT line in the netlist. If there are multiple .FFT lines in the netlist with the same ov then

the corresponding .MEASURE FFT statements will use the first such one.

### AT=value

A frequency *at which* the measurement calculation will occur. This is used by the FIND measure only. The entered AT value will be rounded to the nearest harmonic frequency, as defined by the FREQ, START and STOP parameters on the associated .FFT line. An AT value that rounds to a harmonic frequency of less than zero, or to more than NP/2, will produce a failed measure in Xyce, where NP is the number of points specified on the associated .FFT line. The behavior of these "failed" cases may differ from commercial simulators.

### BINSIZ=value

This parameter is implemented in Xyce for the ENOB, SFDR and SNDR measure types. It can be used to account for any "broadening" of the spectral energy in the first harmonic of the signal, as discussed below. BINSIZ has a default value of 0.

## DEFAULT\_VAL=value

If the conditions specified for finding a given value are not found during the simulation then the measure will return the default value of -1 in the circuitFileName.mt# file. The measure value in the standard output or log file will be FAILED. The default return value for the circuitFileName.mt# file is settable by the user for each measure by adding the qualifier DEFAULT\_VAL=<retval> on that measure line. If either .OPTIONS MEASURE MEASFAIL=<val> or .OPTIONS MEASURE DEFAULT\_VAL=<val> are given in the netlist then those values override the DEFAULT\_VAL parameters given on individual .MEASURE FFT lines. See Section 2.1.25 for more details.

#### MAXFREQ=value

The maximum frequency over which to perform a SFDR, SNR or THD measure. The entered MAXFREQ value will be rounded to the nearest harmonic frequency, as defined by the FREQ, START and STOP parameters on the associated .FFT line. The default value is NP/2, where NP is the number of points specified on the associated .FFT line.

#### MINFREQ=value

The minimum frequency over which to perform a SFDR or THD measure. The entered MINFREQ value will be rounded to the nearest harmonic frequency, as defined by the FREQ, START and STOP parameters on the associated .FFT line. The default value is 1.

### NBHARM=value

The maximum (integer) number of harmonics over which to perform a THD measure. The default value is NP/2. The NBHARM qualifier has precedence over the MAXFREQ qualifier if both are given on a .MEASURE line.

#### PRECISION=value

The default precision for .MEASURE output is 6 digits after the decimal point. This argument provides a user configurable precision for a given .MEASURE statement that applies to both the .mt # file and standard

output. If .OPTIONS MEASURE MEASDGT=<val> is given in the netlist then that value overrides the PRECISION parameters given on individual .MEASURE lines.

PRINT=value

This parameter controls where the <code>.MEASURE</code> output appears. The default is <code>ALL</code>, which produces measure output in both the <code>.mt#</code> and the standard output. A value of <code>STDOUT</code> only produces measure output to standard output, while a value of <code>NONE</code> suppresses the measure output to both the <code>.mt#</code> file and standard output.

#### 2.1.20.1. Measure Definitions

The ENOB, SNDR, SNR and SFDR measure types use the same definitions as the metrics produced by .FFT lines. Section 2.1.8.3 provides more details on those definitions. (Note: The MAXFREQ and MINFREQ qualifiers from the .MEASURE FFT lines are mapped into the FMAX and FMIN parameters used in those equations.) There are two exceptions.

The first exception is the THD measure. If the optional NBHARM qualifier is not used then the definition given in Section 2.1.8.3 is used. If the NBHARM qualifier is used then it takes precedence over the MAXFREQ qualifier. The THD measure definition is then as follow. Let  $f_0$  be the integer index of the "first harmonic"  $(f_0)$ , as defined in Section 2.1.8.3, from the associated .FFT line. Then the effective value of the upper frequency limit  $(f_2)$  in the THD calculation is NBHARM  $\cdot f_0$ , with the caveat that all of the harmomics will be used if NBHARM < 0 or NBHARM > NP/2.

The second exception is the BINSIZ qualifier for the ENOB, SFDR and SNDR measures. For a non-zero value of BINSIZ, the "signal power" is considered to reside in the harmonic indexes between ( $f_0\pm$  BINSIZ), where the DC value is still excluded from the measure calculations. (Note: This definition for BINSIZ may differ from HSPICE.)

#### 2.1.20.2. Re-Measure

Xyce can re-calculate (or re-measure) the values for <code>.MEASURE FFT</code> statements using existing Xyce output files. Section 2.1.18.4 discusses this topic in more detail for both <code>.MEASURE</code> and <code>.FFT</code> statements.

# 2.1.20.3. Additional Examples

This section provides a simple example how to use the FIND measure, along with the V(), VR(), VI(), VM(), VP() and VDB() operators, to obtain the real and imaginary parts of the FFT coefficients, along with the magnitude and phase of those coefficients, at a specified frequency. Those coefficient values are unnormalized.

```
* Example of obtaining FFT coefficients
.TRAN 0 1
.PRINT TRAN V(1)
.OPTIONS FFT FFT ACCURATE=1 FFTOUT=1
```

```
V1 1 0 1
R1 1 0 1
.FFT V(1) NP=8 WINDOW=HANN
* Unnormalized one-sided FFT cofficients for V(1) at F=1.0
* Magnitude
.MEASURE FFT V1AT1 FIND V(1) AT=1.0
* Real part
.MEASURE FFT VR1AT1 FIND VR(1) AT=1.0
* Imaginary part
.MEASURE FFT VI1AT1 FIND VI(1) AT=1.0
* Magnitude
.MEASURE FFT VM1AT1 FIND VM(1) AT=1.0
* Phase
.MEASURE FFT VP1AT1 FIND VP(1) AT=1.0
* Magnitude in dB
.MEASURE FFT VDB1AT1 FIND VDB(1) AT=1.0
.END
```

## The .MEASURE output is then:

FINDV1AT1 = 5.200051e-01 FINDVR1AT1 = -4.804221e-01 FINDVI1AT1 = -1.989973e-01 FINDVM1AT1 = 5.200051e-01 FINDVP1AT1 = -1.575000e+02 FINDVDB1AT1 = -5.679847e+00

## 2.1.21. . MODEL (Model Definition)

The .MODEL command provides a set of device parameters to be referenced by device instances in the circuit.

General Form .MODEL <model name> <model type> (<name>=<value>) \*

# **Examples**

```
.MODEL RMOD R (RSH=1)
```

.MODEL MOD1 NPN BF=50 VAF=50 IS=1.E-12 RB=100 CJC=.5PF TF=.6NS

.MODEL NFET NMOS(LEVEL=1 KP=0.5M VTO=2V)

# Arguments and Options

model name

The model name used to reference the model.

model type

The model type used to define the model. This determines if the model is (for example) a resistor, or a MOSFET, or a diode, etc. For transistors, there will usually be more than one type possible, such as NPN and PNP for BJTs, and NMOS and PMOS for MOSFETs.

name value

The name of a parameter and its value. Most models will have a list of parameters available for specification. Those which are not set will receive default values. Most will be floating point numbers, but some can be integers and some can be strings, depending on the definition of the model.

### **Comments**

The scoping rules for models are:

- If a .MODEL, statement is included in the main circuit netlist, then it is accessible from the main circuit and all subcircuits.
- . MODEL statements defined within a subcircuit are scoped to that subcircuit definition. So, their models are only accessible within that subcircuit definition, as well as within "nested subcircuits" also defined within that subcircuit definition.

Additional illustative examples of scoping are given in the "Working with Subcircuits and Models" section of the Xyce Users' Guide [1].

A model name can be the same as a device name in Xyce. However, that usage will generate a warning message during netlist parsing. The reason is that it can lead to ambiguous .PRINT lines when a model parameter and instance parameter, for a given device, have the same name but a different meaning. For example, R1 could be used as both a resistor device-name, and as a resistor model-name. However, .PRINT TRAN R1:R would then be ambiguous. In addition, the use of duplicate model and device names is not recommended if those names will be used within a Xyce expression since that can result in an ambiguous expression.

#### 2.1.21.1. LEVEL Parameter

A common parameter is the **LEVEL** parameter, which is set to an integer value. This parameter will define exactly which model of the given type is to be used. For example, there are many different available MOSFET models. All of them will be specified using the same possible names and types. The way to differentiate (for example) between the BSIM3 model and the PSP model is by setting the appropriate **LEVEL**.

### 2.1.21.2. Model Binning

Model binning is supported for MOSFET models. For model binning, the netlist contains a set of similar .MODEL cards which correspond to different sizing information (length and width). They are similar in that they are for the same model (and same LEVEL number), and have the same prefix. They are different in that they have different lmin, lmax, wmin, wmax parameters, and the name suffix will be the bin number. For a MOSFET device instance, Xyce will automatically select the appropriate binned model, based on the L and W parameters of that instance. It will only seach the models with matching name prefixes, and can only work if all the binned models have specified all the lmin, lmax, wmin, wmax parameters.

Model binning is enabled by default. To disable it, specify .options parser model\_binning=false.

```
* Model binning example adapted from the BSIM4 tests
m1 2 1 0 b nch L=0.11u W=10.1u NF=5 rgeomod=1 geomod=0
vgs 1 0 1.2
vds 2 0 1.2
vds 2 0 1.2
Vb b 0 0.0

.dc vds 0.0 1.21 0.02 vgs 0.2 1.21 0.2

.print dc v(2) v(1) i(vds)

* model binning
.model nch.1 nmos(level=14
+ lmin=0.1u lmax=20u
+ wmin=0.1u wmax=10u)
.model nch.2 nmos(level=14
+ lmin=0.1u lmax=20u
+ wmin=10u wmax=100u)
.end
```

Figure 2-1. Model Binning Example

#### 2.1.21.3. Model Interpolation

NOTE: The temperature interpolation model described in this section has been deprecated and may be removed in a future version of Xyce.

Traditionally, SPICE simulators handle thermal effects by coding temperature dependence of model parameters into each device. These expressions modify the nominal device parameters given in the . MODEL card when the ambient temperature is not equal to **TNOM**, the temperature at which parameters were extracted.

These temperature correction equations may be reasonable at temperatures close to **TNOM**, but Sandia users of Xyce have found them inadequate when simulations must be performed over a wide range of temperatures. To address this inadequacy, Xyce implements a model interpolation option that allows the user to specify multiple . MODEL cards, each extracted from real device measurements at a different **TNOM**. From these model cards, Xyce will interpolate parameters based on the ambient temperature using either piecewise linear or quadratic interpolation.

Interpolation of models is accessed through the model parameter **TEMPMODEL** in the models that support this capability. In the netlist, a base model is specified, and is followed by multiple models at other temperatures.

Interpolation of model cards in this fashion is implemented in the BJT level 1, JFET, MESFET, and MOSFETS levels 1-6, 10, and 18.

The use of model interpolation is best shown by example:

Note that the model names are all identical for the three .MODEL lines, and that they all specify TEMPMODEL=QUADRATIC, but with different TNOM. For parameters that appear in all three .MODEL lines, the value of the parameter will be interpolated using the TEMP= value in the device line, which in this example is  $40^{\circ}\text{C}$ , in the first line. For parameters that are not interpolated, such as RD, it is not necessary to include these in the second and third .MODEL lines.

The only valid arguments for **TEMPMODEL** are **QUADRATIC** and **PWL** (piecewise linear). The quadratic method includes a limiting feature that prevents the parameter value from exceeding the range of values specified in the .MODEL lines. For example, the **RS** value in the example would take on negative values for most of the interval between -55 and 27, as the value at 90 is very high. This truncation is necessary as parameters can easily take on values (such as the negative resistance of **RS** in this example) that will cause a Xyce failure.

With the BJT parameters **IS** and **ISE**, interpolation is done not on the parameter itself, but on the log of the parameter, which provides for excellent interpolation of these parameters that vary over many orders of magnitude, and with this type of temperature dependence.

The interpolation scheme used for model interpolation bases the interpolation on the difference between the ambient temperature and the **TNOM** value of the first model card in the netlist, which can sometimes lead to poorly conditioned interpolation. Thus it is often best that the first model card in the netlist be the one that has the "middle" **TNOM**, as in the example above. This ensures that no matter where in the range of temperature values the ambient temperature lies, it is a minimal distance from the base point of the interpolation.

# 2.1.22. . NODESET (Approximate Initial Condition, Bias point)

The .NODESET command sets initial conditions for operating point calculations. It is similar to .IC (Section 2.1.14), except it is applied as an initial guess, rather than as a firmly enforced condition. Like .IC, .NODESET initial conditions can be specified for some or all of the circuit nodes.

Consult the Xyce Users' Guide [1] for more guidance.

General Form .NODESET < V(<node>) = <value>

.NODESET <node> <value>

**Examples** . NODESET V(2) = 3.1

.NODESET 2 3.1

#### **Comments**

The Xyce .NODESET command uses a different strategy than either SPICE or HSPICE. When .NODESET is specified, Xyce does two solves for the DC operating point. One with the .NODESET values held as initial conditions (i.e., the same as if it was an .IC solve). The second solve is then done without any conditions imposed, but with the first solution as an initial guess.

The .NODESET capability can only set voltage values, not current values.

The .  ${\tt NODESET}$  capability can not be used, within subcircuits, to set voltage values on global nodes.

# 2.1.23. NOISE (Noise Analysis)

Calculates the the small signal noise response of a circuit over a range of frequencies. The .NOISE command can specify a linear sweep, decade logarithmic sweep, octave logarithmic sweep, or a data table of multivariate values.

# **General Form**

.NOISE V(OUTPUT <, REF>) SRC <sweep type> <points value> + <start frequency value> <end frequency value>

# **Examples**

.NOISE V(5) VIN LIN 101 100Hz 200Hz .NOISE V(5,3) V1 OCT 10 1kHz 16kHz .NOISE V(4) V2 DEC 20 1MEG 100MEG .NOISE V(4) V2 DATA=

# Arguments and Options

V(OUTPUT <, REF>)

The node at which the total output noise is desired. If REF is specified, then the noise voltage V(OUTPUT) - V(REF) is calculated. By default, REF is assumed to be ground.

SRC

The name of an independent source to which input noise is referred.

sweep type

Must be LIN, OCT, or DEC, as described below.

LIN Linear sweep

The sweep variable is swept linearly from the starting to the ending value.

OCT Sweep by octaves

The sweep variable is swept logarithmically by octaves.

DEC Sweep by decades

The sweep variable is swept logarithmically by decades.

DATA Sweep values from a table

Sweep variables are applied based on the rows of a data table. This format allows magnitude and phase to be swept in addition to frequency. If using this format, then the V(OUTPUT <, REF>) and SRC arguments are still needed on the .NOISE line.

points value

Specifies the number of points in the sweep, using an integer greater than or equal to 1.

```
start frequency value end frequency value
```

The end frequency value must not be less than the start frequency value, and both must be greater than zero. The whole sweep must include at least one point.

#### **Comments**

Noise analysis is a linear analysis. The simulator calculates the noise response by linearizing the circuit around the bias point.

If specifying the sweep points using the DATA type, one can also sweep the magnitude and phase of an AC source, as well as the values of linear model parameters. However, unlike the use of DATA for .STEP and .DC, it is not possible to sweep nonlinear device parameters. This is because changing other nonlinear device parameters would alter the correct DCOP solution, and the NOISE sweep happens after the DCOP calculation in the analysis flow. To sweep a nonlinear device parameter on a NOISE problem, add a .STEP command to the netlist to provide an outer parametric sweep around the analysis.

If .DATA is used with .NOISE then the integrals for the total input noise and total output noise will only be calculated, and sent to stdout, if the frequencies in the data table are monotonically increasing.

A .PRINT NOISE must be used to get the results of the NOISE sweep analysis. See Section 2.1.31.

Noise analysis is a relatively new feature to Xyce, so not all noise models have been supported.

Power calculations (P(<device>) and W(<device>) are not supported for any devices for noise analysis. Current variables (e.g., I(<device>)) are only supported for devices that have "branch currents" that are part of the solution vector. This includes the V, E, H and L devices. It also includes the voltage-form of the B device.

# 2.1.24. OP (Bias Point Analysis)

The .OP command causes detailed information about the bias point to be printed.

#### **General Form**

.OP

### **Comments**

This type of analysis can be specified by itself, in which case Xyce will run a nominal operating point. However, if specified with another analysis type, no additional operating point will be calculated, as most analyses require a DC operating point for initialization.

If no analysis command is provided, .OP will run a DC Operating Point calculation (i.e., a DC analysis) with all the voltage sources left at their nominal (instance line) values.

The Xyce .OP statement may provide less, or different, output than other simulators. For some of the missing quantities, a Xyce .PRINT line can give similar information. Nodal voltages are always available on a .PRINT line. Device currents for many devices are available on a .PRINT line using the lead current notation (I (devicename)). Similarly, device power is available on a .PRINT line via P (devicename) or W (devicename). However, these capabilities are not supported in all devices. Table 2-35 shows which devices support these lead current and power notations. Currently, there is no way to print out internal capacitances.

## 2.1.25. OPTIONS Statements

Set various simulation limits, analysis control parameters and output parameters. In general, they use the following format:

General Form .OPTIONS <pkg> [<name>=<value>] \*

Examples .OPTIONS TIMEINT ABSTOL=1E-8

# Arguments and Options

pkg

DEVICE Device Model

TIMEINT Time Integration

NONLIN Nonlinear Solver

NONLIN-TRAN Transient Nonlinear Solver

NONLIN-HB HB Nonlinear Solver

LOCA Continuation/Bifurcation Tracking

LINSOL Linear Solver

LINSOL-HB HB Linear Solver

LINSOL-AC AC Linear Solver

OUTPUT Output

RESTART Restart

SAMPLES Sampling analysis and non-intrusive Polynomial

Chaos (PCE)

EMBEDDEDSAMPLES EmbeddedSampling and non-intrusive Polynomial

Chaos (PCE)

PCES Fully intrusive Polynomial Chaos (PCE)

SENSITIVITY Direct and Adjoint sensitivities

HBINT Harmonic Balance (HB)

DIST Distribution

MEASURE Measure
PARSER Parsing

name value

The name of the parameter and the value it will be assigned.

## **Comments**

Exceptions to this format are the OUTPUT and RESTART options, which use their own format. They are defined under their respective descriptions.

The designator pkg refers loosely to a *module* in the code. Thus, the term is used here as identifying a specific module to be controlled via *options* set in the netlist input file.

# 2.1.25.1. OPTIONS DEVICE (Device Package Options)

The device package parameters listed in Table 2-3 outline the options available for specifying device specific parameters. Some of these (DEFAS, DEFAD, TNOM etc.) have the same meaning as they do for the .OPTION line from Berkeley SPICE (3f5). Parameters which apply globally to all device models will be specified here. Parameters specific to a particular device instance or model are specified in section 2.3.

**Table 2-3. Options for Device Package** 

| Option       | Description   | Default              |
|--------------|---|----------------------|
| DEFAD        | MOS Drain Diffusion Area  | 0.0                  |
| DEFAS        | MOS Source Diffusion Area   | 0.0                  |
| DEFL         | MOS Default Channel Length  | 1.0E-4               |
| DEFW         | MOS Default Channel Width   | 1.0E-4               |
| DIGINITSTATE | This option controls the behavior of the Digital Latch (DLTCH), D Flip-Flop (DFF), JK Flip-Flop (JKFF) and T Flip-Flop (TFF) behavioral digital devices during the DC Operating Point (DCOP) calculations. See 2.3.28 for more details.   | 3                    |
| GMIN         | Minimum Conductance   | 1.0E-12              |
| MINRES       | This is a minimum resistance to be used in place of the default zero value of semiconductor device internal resistances. It is only used when model specifications (.MODEL cards) leave the parameter at its default value of zero, and is not used if the model explicitly sets the resistance to zero.    | 0.0                  |
| MINCAP       | This is a minimum capacitance to be used in place of the default zero value of semiconductor device internal capacitances. It is only used when model specifications (.MODEL cards) leave the parameter at its default value of zero, and is not used if the model explicitly sets the capacitance to zero. | 0.0                  |
| TEMP         | Temperature   | 27.0 °C<br>(300.15K) |
| TNOM         | Nominal Temperature   | 27.0 °C<br>(300.15K) |
| NUMJAC       | Numerical Jacobian flag (only use for small problems)   | 0 (FALSE)            |
| VOLTLIM      | Voltage limiting  | 1 (TRUE)             |

**Table 2-3. Options for Device Package** 

|                 | <u> </u>   |           |
|-----------------|--|-----------|
| Option          | Description  | Default   |
| B3SOIVOLTLIM    | BSIMSOI3 Voltage limiting. This flag is similar to VOLTLIM, except that it only applies to the BSIMSOI version 3 (the newer versions of the BSIM SOI do not have voltage limiting). Turning this off will often improve numerical robustness. Unlike VOLTLIM, turning this off does not disable the initial condition code in the BSIMSOI model.   | 1 (TRUE)  |
| icFac           | This is a multiplicative factor which is applied to right-hand side vector loads of .IC initial conditions during the DCOP phase.  | 10000.0   |
| LAMBERTW        | This flag determines if the Lambert-W function should be applied in place of exponentials in hard-to-solve devices. This capability is implemented in the diode and BJT. Try this for BJT circuits that have convergence problems. For best effect, this option should be tried with voltlim turned off. A detailed explanation of the Lambert-W function, and its application to device modeling can be found in reference [8]. | 0 (FALSE) |
| MAXTIMESTEP     | Maximum time step size   | 1.0E+99   |
| SMOOTHBSRC      | This flag enables smooth transitions by adding a RC network to the output of ABM devices   | 0         |
| RCCONST         | This option controls the smoothness of the transitions if the SMOOTHBSRC flag is enabled. This is done by specifying the RC constant of the RC network   | 1e-9      |
|                 | MOSFET Homtopy parameters  |           |
| VDSSCALEMIN     | Scaling factor for Vds   | 0.3       |
| VGSTCONST       | Initial value for Vgst   | 4.5 Volt  |
| LENGTH0         | Initial value for length   | 5.0e-6    |
| WIDTHO          | Initial value for width  | 200.0e-6  |
| TOXO            | Initial value for oxide thickness  | 6.0e-8    |
| 10710           | maar varae 101 Ontoe anemiess  | 0.00      |
|                 | Debug output parameters  |           |
| DEBUGLEVEL      | The higher this number, the more info is output  | 1         |
| DEBUGMINTIMESTE | First time-step debug information is output  | 0         |
| DEBUGMAXTIMESTE | Last time-step of debug output   | 65536     |
| DEBUGMINTIME    | Same as DEBUGMINTIMESTEP except controlled by time (sec.) instead of step number   | 0.0       |
| DEBUGMAXTIME    | Same as DEBUGMAXTIMESTEP except controlled by time (sec.) instead of step number   | 100.0     |

# 2.1.25.2. .OPTIONS TIMEINT (Time Integration Options)

The time integration parameters listed in Table 2-4 give the available options for helping control the time integration algorithms for transient analysis.

Time integration options are set using the .OPTIONS TIMEINT command.

Table 2-4. Options for Time Integration Package.

| Option           | Description  | Default  |
|------------------|--|--|
|                  | Time integration method. This parameter is only relevant when running Xyce in transient mode. Supported methods:   | trap or 7<br>(variable                           |
| METHOD           | • trap or 7 (variable order Trapezoid)   | order  |
|                  | • gear or 8 (Gear method)  | Trapezoid)                                       |
| RELTOL           | Relative error tolerance   | 1.0E-03  |
| ABSTOL           | Absolute error tolerance   | 1.0E-06  |
| RESTARTSTEPSCALE | This parameter is a scalar which determines how small the initial time step out of a breakpoint should be. In the current version of the time integrator, the first step after a breakpoint isn't subjected to much error analysis, so for very stiff circuits, this step can be problematic.  | 0.005  |
| NLNEARCONV       | This flag sets if "soft" failures of the nonlinear solver, when the convergence criteria are almost, but not quite, met, should result in a "success" code being returned from the nonlinear solver to the time integrator. If this is enabled, it is expected that the error analysis performed by the time integrator will be the sole determination of whether or not the time step is considered a "pass" or a "fail". This is on by default, but occasionally circuits need tighter convergence criteria. | 0 (FALSE)  |
| NLSMALLUPDATE    | This flag is another "soft" nonlinear solver failure flag. In this case, if the flag is set, time steps in which the nonlinear solver stalls, and is using updates that are numerically tiny, can be considered to have converged by the nonlinear solver. If this flag is set, the time integrator is responsible for determining if a step should be accepted or not.  | 1 (TRUE)   |
| RESETTRANNLS     | The nonlinear solver resets its settings for the transient part of the run to something more efficient (basically a simpler set of options with smaller numbers for things like max Newton step). If this is set to false, this resetting is turned off. Normally should be left as default.   | 1 (TRUE)   |
| MAXORD           | This parameter determines the maximum order of integration that time integrators will attempt. Setting this option does not guarantee that the integrator will integrate at this order, it just sets the maximum order the integrator will attempt. In order to guarantee a particular order is used, see the option MINORD below.   | 2 for variable<br>order<br>Trapezoid<br>and Gear |

**Table 2-4. Options for Time Integration Package.** 

| Option        | Description  | Default   |
|---------------|--|-----------|
| MINORD        | This parameter determines the minimum order of integration that time integrators will attempt to maintain. The integrator will start at Backward Euler and move up in order as quickly as possible to achive MINORD and then it will keep the order above this. If MINORD is set at 2 and MAXORD is set at 2, then the integrator will move to second order as quickly as possible and stay there.   | 1         |
|               | This parameter determines the reference value for relative convergence criterion in the local truncation error based time step control. The supported choices  • 0. The reference value is the current value on each node.   |           |
| NEWLTE        | • 1. The reference value is the maximum of all the signals at the current time.  | 1         |
|               | • 2. The reference value is the maximum of all the signals over all past time.   |           |
|               | • 3. The reference value is the maximum value on each signal over all past time.   |           |
| NEWBPSTEPPING | This flag sets a new time stepping method after a break point. Previously, Xyce treats each breakpoint identically to the DCOP point, in which the intitial time step out of the DCOP is made to be very very small, because the LTE calculation is unreliable. As a result, Xyce takes an incredibly small step out of each breakpoint and then tries to grow the stepsize from there. When NEWBPSTEPPING is set, Xyce can take a reasonable large step out of every non-DCOP breakpoint, and then just relies on the step control to ensure that the step is small enough.  Note that the new time stepping method after a break point does not work well with the old LTE calculation since the old LTE calculation is conservative and it tends to reject the first time step out of a break point. We recommend to use newlte if you choose to use the new time stepping method out of a break point. | 1 (TRUE)  |
| MASKIVARS     | This parameter masks out current variables in the local truncation error (LTE) based time step control.  | 0 (FALSE) |

**Table 2-4. Options for Time Integration Package.** 

| Option          | Description  | Default                                  |
|-----------------|--|--|
| ERROPTION       | This parameter determines if Local Truncation Error (LTE) control is turned on or not. If ERROPTION is on, then step-size selection is based on the number of Newton iterations nonlinear solve. For Trapezoid and Gear, if the number of nonlinear iterations is below NLMIN then the step is doubled. If the number of nonlinear iterations is above NLMAX then the step is cut by one eighth. In between, the step-size is left alone. Because this option can lead to very large time-steps, it is very important to specify an appropriate DELMAX option. If the circuit has breakpoints, then the option MINTIMESTEPSBP can also help to adjust the maximum time-step by specifying the minimum number of time points between breakpoints. | 0 (Local<br>Truncation<br>Error is used) |
| NLMIN           | This parameter determines the lower bound for the desired number of nonlinear iterations during a Trapezoid time or Gear integration solve with ERROPTION=1.   | 3  |
| NLMAX           | This parameter determines the upper bound for the desired number of nonlinear iterations during a Trapezoid time or Gear integration solve with ERROPTION=1.   | 8  |
| DELMAX          | This parameter determines the maximum time step-size used with ERROPTION=1. If a maximum time-step is also specified on the .TRAN line, then the minimum of that value and DELMAX is used.   | 1e99                                     |
| MINTIMESTEPSBP  | This parameter determines the minimum number of time-steps to use between breakpoints. This enforces a maximum time-step between breakpoints equal to the distance between the last breakpoint and the next breakpoint divided by MINTIMESTEPSBP.  | 10                                       |
| TIMESTEPSREVERS | This parameter determines whether time-steps are rejected based upon the step-size selection strategy in ERROPTION=1. If it is set to 0, then a step will be accepted with successful nonlinear solves independent of whether the number of Amonlinear iterations is between NLMIN and NLMAX. If it is set to 1, then when the number of nonlinear iterations is above NLMAX, the step will be rejected and the step-size cut by one eighth and retried. If ERROPTION=0 (use LTE) then TIMESTEPSREVERSAL=1 (reject steps) is set.  | 0 (do not<br>reject steps)               |

Table 2-4. Options for Time Integration Package.

| Option         | Description  | Default   |
|----------------|--|---|
| DOUBLEDCOPSTEP | TCAD devices by default will solve an extra "setup" problem to mitigate some of the convergence problems that TCAD devices often exhibit. This extra setup problem solves a nonlinear Poisson equation first to establish an initial guess for the full drift-diffusion(DD) problem. The name of this parameter refers to the fact that the code is solving two DC operating point steps instead of one. To solve only the nonlinear Poisson problem, then set DOUBLEDCOP=nl_poisson. To solve only the drift-diffusion problem (skipping the nonlinear Poisson), set DOUBLEDCOP=drift_diffusion. To explicitly set the default behavior, then set DOUBLEDCOP=nl_poisson, drift_diffusion. | Default value, for TCAD circuits, is a combination: nl_poisson, drift_diffusion. Default value, for non-TCAD circuits is a moot point. If no TCAD devices are present in the circuit, then there will not be an extra DCOP solve. |
| BREAKPOINTS    | This parameter specifies a comma-separated list of timepoints that should be used as breakpoints. They do not replace the existing breakpoints already being set internally by Xyce, but instead will add to them.   | N/A   |
| BPENABLE       | Flag for turning on/off breakpoints $(1 = ON, 0 = OFF)$ . It is unlikely anyone would ever set this to FALSE, except to help debug the breakpoint capability.  | 1 (TRUE)  |
| EXITTIME       | If this is set to nonzero, the code will check the simulation time at the end of each step. If the total time exceeds the exittime, the code will ungracefully exit. This is a debugging option, the point of which is the have the code stop at a certain time during a run without affecting the step size control. If not set by the user, it isn't activated.  | -   |
| EXITSTEP       | Same as EXITTIME, only applied to step number. The code will exit at the specified step. If not set by the user, it isn't activated.   | -   |

# 2.1.25.3. OPTIONS NONLIN (Nonlinear Solver Options)

The nonlinear solver parameters listed in Table 2-5 provide methods for controlling the nonlinear solver for DC, transient and harmonic balance. Note that the nonlinear solver options for DCOP, transient and harmonic balance are specified in separate options statements, using .OPTIONS NONLIN, .OPTIONS NONLIN-TRAN and .OPTIONS NONLIN-HB, respectively. The defaults for .OPTIONS NONLIN-TRAN are specified in the third and fourth columns of Table 2-5. The defaults for .OPTIONS NONLIN-HB are the same as the default settings given for NONLIN-TRAN with two exceptions. For NONLIN-HB, the default for ABSTOL is 1e-9 and the default for RHSTOL is 1e-4.

Table 2-5. Options for Nonlinear Solver Package.

| Option               | Description   | NONLIN<br>Default                  | NONLIN-<br>TRAN<br>Default |
|----------------------|---|------------------------------------|----------------------------|
| NOX                  | Use NOX nonlinear solver.   | 1 (TRUE)                           | 0 (FALSE)                  |
|                      | Nonlinear solution strategy. Supported Strategies:  | _                                  |                            |
|                      | • 0 (Newton)  |                                    |                            |
| NLSTRATEGY           | • 1 (Gradient)  | 0 (Newton)                         | 0 (Newton)                 |
|                      | • 2 (Trust Region)  |                                    |                            |
|                      | Line-search method used by the nonlinear solver. Supported line-search methods:           |                                    |                            |
|                      | • 0 (Full Newton - no line search)  |                                    |                            |
|                      | • 1 (Interval Halving)  | 0 (Full New-                       | 0 (Full                    |
| SEARCHMETHOD         | • 2 (Quadratic Interpolation)   | ton)                               | Newton)                    |
|                      | • 3 (Cubic Interpolation)   |                                    |                            |
|                      | • 4 (More'-Thuente)   |                                    |                            |
|                      | Enables the use of Homotopy/Continuation algorithms for the nonlinear solve. Options are: |                                    |                            |
|                      | • 0 (Standard nonlinear solve)  | 0 (Standard<br>nonlinear<br>solve) |                            |
| CONTINUATION         | • 1 (Natural parameter homotopy. See LOCA options list)                                   |                                    | 0 (Standard nonlinear      |
| - O I T.VO.11 I O.IV | <ul> <li>2/mos (Specialized dual parameter homotopy for<br/>MOSFET circuits)</li> </ul>   |                                    | solve)                     |
|                      | • 3/gmin (GMIN stepping, similar to that of SPICE)  |                                    |                            |
| ABSTOL               | Absolute residual vector tolerance  | 1.0E-12                            | 1.0E-06                    |
| RELTOL               | Relative residual vector tolerance  | 1.0E-03                            | 1.0E-02                    |
| DELTAXTOL            | Weighted nonlinear-solution update norm convergence tolerance                             | 1.0                                | 0.33                       |
| RHSTOL               | Residual convergence tolerance (unweighted 2-norm)  | 1.0E-06                            | 1.0E-02                    |
| SMALLUPDATETOL       | Minimum acceptable norm for weighted nonlinear-solution update                            | 1.0E-06                            | 1.0E-06                    |
| MAXSTEP              | Maximum number of Newton steps  | 200                                | 20                         |
| MAXSEARCHSTEP        | Maximum number of line-search steps   | 2                                  | 2                          |
| IN_FORCING           | Inexact Newton-Krylov forcing flag  | 0 (FALSE)                          | 0 (FALSE)                  |
| AZ_TOL               | Sets the minimum allowed linear solver tolerance. Valid only if IN_FORCING=1.             | 1.0E-12                            | 1.0E-12                    |
|                      |   |                                    |                            |

Table 2-5. Options for Nonlinear Solver Package.

| Option           | Description   | NONLIN<br>Default | NONLIN-<br>TRAN<br>Default |
|------------------|---|-------------------|----------------------------|
|                  | If using a line search, this option determines the type of step to take if the line search fails. Supported strategies: |                   |                            |
| RECOVERYSTEPTYPE | • 0 (Take the last computed step size in the line search algorithm)   | 0                 | 0                          |
|                  | • 1 (Take a constant step size set by RECOVERYSTEP)   |                   |                            |
| RECOVERYSTEP     | Value of the recovery step if a constant step length is selected  | 1.0               | 1.0                        |
| DEBUGLEVEL       | The higher this number, the more info is output   | 1                 | 1                          |
| DEBUGMINTIMESTE  | First time-step debug information is output   | 0                 | 0                          |
| DEBUGMAXTIMESTE  | Last time-step of debug output  | 99999999          | 99999999                   |
| DEBUGMINTIME     | Same as DEBUGMINTIMESTEP except controlled by time (sec.) instead of step number  | 0.0               | 0.0                        |
| DEBUGMAXTIME     | Same as DEBUGMAXTIMESTEP except controlled by time (sec.) instead of step number  | 1.0E+99           | 1.0E+99                    |

# 2.1.25.4. OPTIONS LOCA (Continuation and Bifurcation Tracking Package Options)

The continuation selections listed in Table 2-6 provide methods for controlling continuation and bifurcation analysis. These override the defaults and any that were set simply in the continuation package. This option block is only used if the nonlinear solver or transient nonlinear solver enable continuation through the CONTINUATION flag.

There are two specialized homotopy methods that can be set in the nonlinear solver options line. One is MOSFET-based homotopy, which is specific to MOSFET circuits. This is specified using continuation=2 or continuation=mos. The other is GMIN stepping, which is specified using continuation=3 or continuation=gmin. For either of these methods, while it is possible to modify their default LOCA options, it is generally not necessary to do so. Note that Xyce automatically attempts GMIN stepping if the inital attempt to find the DC operating point fails. If GMIN stepping is specified in the netlist, Xyce will not attempt to find a DC operating point without GMIN stepping.

LOCA options are set using the .OPTIONS LOCA command.

Table 2-6. Options for Continuation and Bifurcation Tracking Package.

| Option  | Description                              | Default     |
|---------|--|-------------|
| STEPPER | Stepping algorithm to use:               |             |
|         | • 0 (Natural or Zero order continuation) | 0 (Natural) |
|         | • 1 (Arc-length continuation)            | o (Hatarar) |
|         |  |             |

Table 2-6. Options for Continuation and Bifurcation Tracking Package.

| Option           | Description  | Default      |
|------------------|--|--------------|
|                  | Predictor algorithm to use:  |              |
| DDED I GEOD      | • 0 (Tangent)  |              |
|                  | • 1 (Secant)   | 0 (Tangent)  |
| PREDICTOR        | • 2 (Random)   | 0 (Tangent)  |
|                  | • 3 (Constant)   |              |
|                  | Algorithm used to adjust the step size between continuation steps:   |              |
| STEPCONTROL      | • 0 (Constant)   | 0 (Constant) |
|                  | • 1 (Adaptive)   |              |
| CONPARAM         | Parameter in which to step during a continuation run   | VA:V0        |
| INITIALVALUE     | Starting value of the continuation parameter   | 0.0          |
| MINVALUE         | Minimum value of the continuation parameter  | -1.0E20      |
| MAXVALUE         | Maximum value of the continuation parameter  | 1.0E20       |
| BIFPARAM         | Parameter to compute during bifurcation tracking runs  | VA:V0        |
| MAXSTEPS         | Maximum number of continuation steps (includes failed steps)   |              |
| MAXNLITERS       | Maximum number of nonlinear iterations allowed (set this parameter equal to the MAXSTEP parameter in the NONLIN option block   | 20           |
| INITIALSTEPSIZE  | Starting value of the step size  | 1.0          |
| MINSTEPSIZE      | Minimum value of the step size   | 1.0E20       |
| MAXSTEPSIZE      | Maximum value of the step size   | 1.0E-4       |
| AGGRESSIVENESS   | Value between 0.0 and 1.0 that determines how aggressive the step size control algorithm should be when increasing the step size. 0.0 is a constant step size while 1.0 is the most aggressive.  | 0.0          |
| RESIDUALCONDUCTA | If set to a nonzero (small) number, this parameter will force the GMIN stepping algorithm to stop and declare victory once the artificial resistors have a conductance that is smaller than this AMDERDER. This should only be used in transient simulations, and <i>ONLY</i> if it is absolutely necessary to get past the DC operating point calculation. It is almost always better to fix the circuit so that residual conductance is not necessary. | 0.0          |

# 2.1.25.5. OPTIONS LINSOL (Linear Solver Options)

Xyce uses both sparse direct solvers as well as Krylov iterative methods for the solution of the linear equations generated by Newton's method. For the advanced users, there are a variety of options that can be set to help improve these solvers. Transformations of the linear system have a "TR\_" prefix on the flag. Many of the options for the Krylov solvers are simply passed through to the underlying Trilinos/AztecOO

solution settings and thus have an "AZ\_" prefix on the flag.

Linear solver options are set using the .  ${\tt OPTIONS}\ {\tt LINSOL}$  command.

Table 2-7. Options for Linear Solver Package.

| Option           | Description  | Default   |
|------------------|--|---|
|                  | Determines which linear solver will be used.   |   |
|                  | • KLU  |   |
|                  | • KSparse  |   |
|                  | • SuperLU (optional)   | KLU (Serial,<br>Parallel                          |
|                  | • AztecOO  | < 10 <sup>4</sup>                                 |
| type             | • Belos  | unknowns) AztecOO,                                |
|                  | • ShyLU (optional)   | (Parallel,  |
|                  | Note that while KLU, KSparse, and SuperLU (optional) are available for parallel execution they will solve the linear system in serial. Therefore they will be useful for moderate problem sizes but will not scale in memory or performance for large problems | ≥ 10 <sup>4</sup> unknowns)                       |
|                  | Determines which preconditioner will be used with an iterative linear solver   |   |
| prec_type        | • Ifpack   | Ifpack (If-<br>pack_IlukGraph                     |
|                  | A preconditioner will not be used if a direct solver (KLU, KSparse, SuperLU) is specified.   | pack_nakGraph/                                    |
| use_aztec_precor | Triggers use of native AztecOO preconditioners for the iterative linear solves   | 0 (FALSE)   |
| use_ifpack_facto | Use Ifpack factory to create preconditioner instead of using Ifpack_IlukGraph  | 0 (FALSE)   |
|                  | If using the Ifpack factory, use_ifpack_factory=1, which preconditioner is created   |   |
| i for a la trans | • Amesos (Additive Schwarz w/ KLU subdomain solve)   | Amagag  |
| ifpack_type      | • ILU  | Amesos  |
|                  | • ILUT   |   |
| ShyLU_rthresh    | Relative dropping threshold for Schur complement preconditioner (ShyLU only)   | 1.0E-03   |
|                  | Transformation parameters  |   |
| TR_partition     | Perform load-balance partitioning on the linear system   | 0 (NONE,<br>Serial)<br>1 (Isorropia,<br>Parallel) |
| TR_partition_typ | Eype of load-balance partitioning on the linear system   | HYPERGRAPH  |

Table 2-7. Options for Linear Solver Package.

| Option          | Description  | Default                                       |
|-----------------|--|---|
| TR_singleton_fi | 1 theiggers use of singleton filter for linear system  | 0 (FALSE,<br>Serial) 1<br>(TRUE,<br>Parallel) |
| TR_amd          | Triggers use of approximate minimum-degree (AMD) ordering for linear system                                  | 0 (FALSE,<br>Serial)<br>1 (TRUE,<br>Parallel) |
| TR_global_btf   | Triggers use of block triangular form (BTF) ordering for linear system, requires TR_amd=0 and TR_partition=0 | 0 (FALSE)                                     |
| TR_reindex      | Reindexes linear system parallel global indices in lexigraphical order, recommended with singleton filter    | 1 (TRUE)                                      |
| TR_solvermap    | Triggers remapping of column indices for parallel runs, recommended with singleton filter                    | 1 (TRUE)                                      |
|                 | Iterative linear solver parameters   |   |
| adaptive_solve  | Triggers use of AztecOO adaptive solve algorithm for preconditioning of iterative linear solves              | 0 (FALSE)                                     |
| AZ_max_iter     | Maximum number of iterative solver iterations  | 200   |
| AZ_precond      | AztecOO iterative solver preconditioner flag (used only when use_aztec_precond=1)                            | AZ_dom_decomp                                 |
| AZ_solver       | Iterative solver type  | AZ_gmres (1)                                  |
| AZ_conv         | Convergence type   | AZ_r0 (0)                                     |
| AZ_pre_calc     | Type of precalculation   | AZ_recalc (1)                                 |
| AZ_keep_info    | Retain calculation info  | AZ_true<br>(1)                                |
| AZ_orthog       | Type of orthogonalization  | AZ_modified (1)                               |
| AZ_subdomain_so | Sabdomain solution for domain decomposition preconditioners  | AZ_ilut                                       |
| AZ_ilut_fill    | Approximate allowed fill-in factor for the ILUT preconditioner   | 2.0   |
| AZ_drop         | Specifies drop tolerance used in conjunction with LU or ILUT preconditioners                                 | 1.0E-03                                       |
| AZ_reorder      | Reordering type  | AZ_none (0)                                   |
| AZ_scaling      | Type of scaling  | AZ_none (0)                                   |
| AZ_kspace       | Maximum size of Krylov subspace  | 50  |
| AZ_tol          | Convergence tolerance  | 1.0E-9  |
| AZ_output       | Output level   | AZ_none (0)                                   |

Table 2-7. Options for Linear Solver Package.

| Option           | Description   | Default                     |
|------------------|---|-----------------------------|
|                  |   | 50 (if<br>verbose<br>build) |
| AZ_diagnostics   | Diagnostic information level  | AZ_none (0)                 |
| AZ_overlap       | Schwarz overlap level for ILU preconditioners   | 0                           |
| AZ_rthresh       | Diagonal shifting relative threshold for ILU preconditioners  | 1.0001                      |
| AZ_athresh       | Diagonal shifting absolute threshold for ILU preconditioners  | 1.0E-04                     |
| output_ls        | Write out linear system matrix and right-hand-side vector, post-transformation, to Matrix Market file every # solves  | 0 (no output)               |
| output_base_ls   | Write out linear system matrix and right-hand-side vector, pre-transformation, to Matrix Market file every # solves   | 0 (no output)               |
| output_failed_ls | Write out linear system matrix and right-hand-side vector to<br>s Matrix Market file every # solves when linear solver fails (only<br>available for direct solvers) | 0 (no output)               |

# 2.1.25.6. OPTIONS LINSOL-HB (Linear Solver Options)

For harmonic balance (HB) analysis, Xyce provides both iterative and direct methods for the solution of the steady state. Only matrix-free techniques are available for preconditioning the HB Jacobian with an iterative linear solver. The direct linear solver explicitly forms the HB Jacobian and solves the complex-valued linear system with the requested solver. For HB analysis, a reduced number of linear solver options are available, and are set using the <code>.OPTIONS LINSOL-HB</code> command.

Table 2-8. Options for Linear Solver Package for HB.

| Option          | Description  | Default      |
|-----------------|--|--------------|
|                 |  |              |
| type            | Determines which linear solver will be used                                  |              |
|                 | • AztecOO  | AztecOO      |
|                 | • Belos  |              |
|                 | • Direct   |              |
|                 |  |              |
| prec_type       | Determines which preconditioner will be used with an iterative linear solver |              |
|                 | <ul> <li>block_jacobi</li> </ul>   | block_jacobi |
|                 | A preconditioner will not be used if type=Direct is specified                |              |
| block_jacobi_co | Enable one-step correction to the block_jacobi rrected preconditioner.       | 0 (FALSE)    |

Table 2-8. Options for Linear Solver Package for HB.

| Option        | Description   | Default       |
|---------------|---|---------------|
| direct_solver | Determines which direct linear solver will be used if type=Direct is specified  • LAPACK          | LAPACK        |
| AZ_kspace     | Maximum size of Krylov subspace   | 50            |
| AZ_max_iter   | Maximum number of iterative solver iterations   | 200           |
| AZ_tol        | Convergence tolerance   | 1.0E-9        |
| output_ls     | Write out linear system matrix and right-hand-side vector to<br>Matrix Market file every # solves | 0 (no output) |

## 2.1.25.7. OPTIONS LINSOL-AC (Linear Solver Options)

For AC analysis, Xyce provides both iterative and direct methods for the solution of the linear equations. For the advanced users, there are a variety of options that can be set to help improve these solvers. Transformations of the linear system have a "TR\_" prefix on the flag. Many of the options for the Krylov solvers are simply passed through to the underlying Trilinos/AztecOO solution settings and thus have an "AZ\_" prefix on the flag.

Linear solver options are set using the .OPTIONS LINSOL-AC command. The available options are the same as those for .OPTIONS LINSOL.

## 2.1.25.8. OPTIONS OUTPUT (Output Options)

The .OPTIONS OUTPUT command can be used to allow control of the output frequency of data to files specified by .PRINT TRAN commands.

One method is to specify output intervals. The format for this method is:

```
.OPTIONS OUTPUT INITIAL_INTERVAL=<interval> [<t0> <i0> [<t1> <i1>]* ]
```

where INITIAL\_INTERVAL=<interval> specifies the starting interval time for output and <tx> <ix> specifies later simulation times <tx> where the output interval will change to <ix>. The solution is output at the exact intervals requested; this is done by interpolating the solution to the requested time points.

Another useful method for controlling the output frequency is to specify discrete output points.

```
.OPTIONS OUTPUT OUTPUTTIMEPOINTS=<t0>,<t1>,*
```

If this option is used, then only the specified time points will appear in the output file. No other points will be output, so files using this method can be very sparse. For this type of output, the output values are not interpolated. Instead, the specified output points are set as breakpoints in the time integrator, so the output values are computed directly.

In addition to controlling the frequency of output, it is also possible to use output options to suppress the header from standard format output files, and the footer from both standard and tecplot format output files.

```
.OPTIONS OUTPUT PRINTHEADER=<boolean> PRINTFOOTER=<boolean>
```

where setting the PRINTHEADER variable to "false" will suppress the header and PRINTFOOTER variable to "false" will suppress the footer. The PRINTHEADER option is only applicable to .PRINT <analysis> FORMAT=<STD|GNUPLOT|SPLOT> files. The PRINTFOOTER option is only applicable to .PRINT <analysis> FORMAT=<STD|GNUPLOT|SPLOT|TECPLOT> files.

It is possible to add a STEPNUM column as the first column in the output file.

```
.OPTIONS OUTPUT ADD_STEPNUM_COL=<boolean>
```

where setting the ADD\_STEPNUM\_COL variable to "true" will add the STEPNUM column. The default is "false". This option is applicable to FORMAT=<STD|NOINDEX|GNUPLOT|SPLOT> for any .PRINT line that supports FORMAT=STD output.

The default Xyce output for phase operators, such as VP(), IP(), SP(), YP() and ZP(), is in degrees. For compatibility with other simulators like Spice3f5 and ngspice, it is possible to change that operator output to use radians instead:

```
.OPTIONS OUTPUT PHASE_OUTPUT_RADIANS=<boolean>
```

The default value for this option is FALSE. If set to TRUE then the phase output will be in radians instead of degrees. This option also applies to the format for AC sensitivity output. It does not affect the output from a .FOUR analysis or a texttt.FOUR measure though. Those two outputs are always in degrees.

## 2.1.25.9. OPTIONS RESTART (Checkpointing Options)

The .OPTIONS RESTART command is used to control all checkpoint output and restarting.

The checkpointing form of the .OPTIONS RESTART command takes the following format:

#### **General Format:**

```
.OPTIONS RESTART [PACK=<0|1>] JOB=<job prefix>
+ [INITIAL_INTERVAL=<initial interval time> [<t0> <i0> [<t1> <i1>] *
```

PACK=<0 | 1> indicates whether the restart data will be byte packed or not. Parallel restarts must always be packed while Windows/MingW runs are always not packed. Otherwise, data will be packed by default unless explicitly specified.  $JOB=<job\ prefix>$  identifies the prefix for restart files. The actual restart files will be the job name with the current simulation time appended (e.g. name1e-05 for JOB=name and simulation time 1e-05 seconds). Furthermore,  $INITIAL\_INTERVAL=<initial\ interval\ time>$  identifies the initial interval time used for restart output. The <tx><ix> intervals identify times <tx> at which the output interval (ix) should change. This functionality is identical to that described for the .OPTIONS OUTPUT command.

**Examples** To generate checkpoints at every time step (default):

```
Example: .OPTIONS RESTART JOB=checkpt
```

To generate checkpoints every 0.1  $\mu s$ :

```
Example: .OPTIONS RESTART JOB=checkpt INITIAL_INTERVAL=0.1us
```

To generate unpacked checkpoints every 0.1  $\mu s$ :

```
Example: .OPTIONS RESTART PACK=0 JOB=checkpt INITIAL_INTERVAL=0.1us
```

To specify an initial interval of 0.1  $\mu s$ , at 1  $\mu s$  change to interval of 0.5  $\mu s$ , and at 10  $\mu s$  change to interval of 0.1  $\mu s$ :

## **Example:**

```
.OPTIONS RESTART JOB=checkpt INITIAL_INTERVAL=0.1us 1.0us + 0.5us 10us 0.1us
```

## 2.1.25.10. OPTIONS RESTART (Restarting Options)

To restart from an existing restart file, specify the file by either FILE=<restart file name> to explicitly use a restart file or by JOB=<job name> START\_TIME=<specified name> to specify a file prefix and a specified time. The time must exactly match an output file time for the simulator to correctly identify the correct file. To continue generating restart output files,

INITIAL\_INTERVAL=<interval> and following intervals can be appended to the command in the same format as described above. New restart files will be packed according to the previous restart file read in.

The restarting form of the .OPTIONS RESTART command takes the following format:

#### **General Format:**

```
.OPTIONS RESTART FILE=<restart file name>|JOB=<job name>
START_TIME=<time>
+ [ INITIAL_INTERVAL=<interval> [<t0> <i0> [<t1> <i1>] * ]]
```

**Examples** Example restarting from checkpoint file at 0.133  $\mu s$ :

```
Example: .OPTIONS RESTART JOB=checkpt START_TIME=0.133us
```

To restart from checkpoint file at 0.133  $\mu s$ :

```
Example: .OPTIONS RESTART FILE=checkpt0.000000133
```

Restarting from 0.133  $\mu s$  and continue checkpointing at 0.1  $\mu s$  intervals:

#### **Example:**

.OPTIONS RESTART FILE=checkpt0.000000133 JOB=checkpt\_again + INITIAL INTERVAL=0.1us

#### 2.1.25.11. OPTIONS RESTART: special notes for use with two-level-Newton

Large parallel problems which involve power supply parasitics often require a two-level solve, in which different parts of the problem are handled separately. In most respects, restarting a two-level simulation is similar to restarting a conventional simulation. However, there are a few differences:

- When running with a two-level algorithm, Xyce requires (at least) two different input files. In order to do a restart of a two-level Xyce simulation, it is necessary to have an .OPTIONS RESTART statement in each file.
- It is necessary for the statements to be consistent. For example, the output times must be exactly the same, meaning the initial intervals must be exactly the same.
- Xyce will *not* check to make sure that the restart options used in different files match, so it is up to the user to ensure matching options.
- Finally, as each netlist that is part of a two-level solve will have its own .OPTIONS RESTART statement, that means that each netlist will generate and/or use its own set of restart files. As a result, the restart file name used by each netlist must be unique.

#### 2.1.25.12. .OPTIONS SAMPLES (Sampling options)

The sampling selections listed in Table 2-9 provide methods for controlling Monte Carlo and Latin Hypercube Sampling methods.

SAMPLES options are set using the .OPTIONS SAMPLES command. They are only used if the netlist also includes a .SAMPLING statement.

Table 2-9. Options for Sampling Package.

| Option          | Description  | Default                    |
|-----------------|--|----------------------------|
| NUMSAMPLES      | Total number of samples  | 0                          |
| SAMPLE_TYPE     | Sampling type (MC or LHS)  | MC                         |
| OUTPUTS         | Comma separated list of outputs (anything that would be a valid .RESULT output command)    | -                          |
| MEASURES        | Comma separated list of measure names (must refer to .MEASURE commands in the netlist)     | -                          |
| COVMATRIX       | Covariance matrix specified in row major form as comma-separated double precision numbers. | _                          |
| SEED            | Random seed  | See footnote. <sup>1</sup> |
| OUTPUT_SAMPLE_S | Compute and outputs statistics for specified outputs and/or measures.                      | _                          |

Table 2-9. Options for Sampling Package.

| Option          | Description   | Default |
|-----------------|---|---------|
| REGRESSION_PCE  | Enable regression based PCE. If this is enabled, the randomly sampled points will be used to produce a PCE approximation using regression methodss.   | -       |
| PROJECTION_PCE  | Enable projection based PCE (quadrature). If this is enabled, a PCE approximation will be created using quadrature methods. The NUMSAMPLES parameter will be ignored, and the samples will be the quadrature points used by projection PCE. | -       |
| RESAMPLE        | Once the PCE coefficients are obtained, perform sampling on the PCE approximation   | _       |
| OUTPUT_PCE_COEF | F SOutput the PCE coefficients  | _       |
| SPARSE_GRID     | Use sparse grid methods if using projection PCE.  | _       |
| STDOUTPUT       | Send sampling and PCE output to the terminal  | _       |

## 2.1.25.13. . OPTIONS EMBEDDEDSAMPLES (Embedded Sampling options)

The sampling selections listed in Table 2-10 provide methods for controlling Embedded Sampling methods.

EMBEDDEDSAMPLES options are set using the .OPTIONS EMBEDDEDSAMPLES command. They are only used if the netlist also includes a .EMBEDDEDSAMPLING statement.

Table 2-10. Options for Embedded Sampling Package.

| Option  | Description  | Default                    |
|---|--|----------------------------|
| NUMSAMPLES  | Total number of samples  | 0                          |
| SAMPLE_TYPE   | Sampling type (MC or LHS)  | MC                         |
| OUTPUTS   | Comma separated list of outputs (anything that would be a valid .PRINT output variable)  | _                          |
| COVMATRIX   | Covariance matrix specified in row major form as comma-separated double precision numbers.   | _                          |
| SEED  | Random seed  | See footnote. <sup>1</sup> |
| OUTPUT_SAMPLE_STACtompute and outputs statistics for specified outputs. |  | _                          |
| REGRESSION_PCE  | Enable regression based PCE. If this is enabled, the randomly sampled points will be used to produce a PCE approximation using regression methods. | -                          |

<sup>&</sup>lt;sup>1</sup>The seed can also be set using command line option, -randseed. The command line seed will override the netlist seed value. If the seed is not set in either the netlist or on the command line, then Xyce generates a seed internally. In all cases, Xyce will output text to the console indicating what seed is being used.

Table 2-10. Options for Embedded Sampling Package.

| Option          | Description   | Default |
|-----------------|---|---------|
| PROJECTION_PCE  | Enable projection based PCE (quadrature). If this is enabled, a PCE approximation will be created using quadrature methods. The NUMSAMPLES parameter will be ignored, and the samples will be the quadrature points used by projection PCE. | -       |
| RESAMPLE        | Once the PCE coefficients are obtained, perform sampling on the PCE approximation   | _       |
| OUTPUT_PCE_COEF | F Output the PCE coefficients   | _       |
| SPARSE_GRID     | Use sparse grid methods if using projection PCE.  | -       |
| STDOUTPUT       | Send sampling and PCE output to the terminal  | _       |

### 2.1.25.14. OPTIONS PCES (Fully intrusive PCE options)

The sampling selections listed in Table 2-11 provide methods for controlling Embedded Sampling methods.

PCES options are set using the .OPTIONS PCES command. They are only used if the netlist also includes a .PCE statement.

Table 2-11. Options for PCE Package.

| Option          | Description  | Default                    |
|-----------------|--|----------------------------|
| OUTPUTS         | Comma separated list of outputs (anything that would be a valid .PRINT output variable)    | -                          |
| COVMATRIX       | Covariance matrix specified in row major form as comma-separated double precision numbers. | -                          |
| SAMPLE_TYPE     | Sampling type (MC or LHS). This is only used if resampling is enabled.                     | MC                         |
| SEED            | Random seed. This is only used if resampling is enabled.                                   | See footnote. <sup>1</sup> |
| OUTPUT_SAMPLE_S | TACKSnpute and outputs statistics for specified outputs.                                   | _                          |
| RESAMPLE        | Once the PCE coefficients are obtained, perform sampling on the PCE approximation          | -                          |
| OUTPUT_PCE_COEF | F Output the PCE coefficients  | _                          |
| SPARSE_GRID     | Use sparse grid methods if using projection PCE.   | _                          |
| STDOUTPUT       | Send sampling and PCE output to the terminal   | _                          |

<sup>&</sup>lt;sup>1</sup>The seed can also be set using command line option, -randseed. The command line seed will override the netlist seed value. If the seed is not set in either the netlist or on the command line, then Xyce generates a seed internally. In all cases, Xyce will output text to the console indicating what seed is being used.

<sup>&</sup>lt;sup>1</sup>The seed can also be set using command line option, -randseed. The command line seed will override the netlist seed value. If the seed is not set in either the netlist or on the command line, then Xyce generates a seed internally. In all cases, Xyce will output text to the console indicating what seed is being used.

## 2.1.25.15. OPTIONS SENSITIVITY (Direct and Adjoint Sensitivity Options)

The sensitivity selections listed in Table 2-12 provide methods for controlling direct and adjoint sensitivity analysis.

SENSITIVITY options are set using the .OPTIONS SENSITIVITY command. They are only used if the netlist also includes a .SENS statement.

Table 2-12. Options for Sensitivity Package.

| Option           | Description   | Default |
|------------------|---|---------|
| ADJOINT          | Flag to enable adjoint sensitivity calculation                              | false   |
| DIRECT           | Flag to enable direct sensitivity calculation                               | false   |
| OUTPUTSCALED     | Flag to enable output of scaled sensitivities                               | false   |
| OUTPUTUNSCALED   | Flag to enable output of unscaled sensitivities                             | true    |
| STDOUTPUT        | Flag to enable output of sensitivies to std output                          | false   |
| ADJOINTBEGINTIME | Start time for set of time steps over which to compute transient adjoints.  | 0.0     |
| ADJOINTFINALTIME | adjoints.   | 1.0e+99 |
| ADJOINTTIMEPOINT | List of comma-separated time points at which to compute transient adjoints. | -       |

## 2.1.25.16. OPTIONS HBINT (Harmonic Balance Options)

The Harmonic Balance parameters listed in Table 2-13 give the available options for helping control the algorithm for harmonic balance analysis.

Harmonic Balance options are set using the .OPTIONS HBINT command.

Table 2-13. Options for HB.

| Option         | Description   | Default |
|----------------|---|---------|
| NUMFREQ        | Number of harmonics to be calculated for each tone. It must have the same number of entries as .HB statement  | 10      |
| STARTUPPERIODS | Number of periods to integrate through before calculating the initial conditions. This option is only used when TAHB=1.   | 0       |
| SAVEICDATA     | Write out the initial conditions to a file.   | 0       |
| ТАНВ           | This flag sets transient assisted HB. When TAHB=0, transient analysis is not performed to get an initial guess. When TAHB=1, it uses transient analysis to get an initial guess. For multi-tone HB simulation, the initial guess is generated by a single tone transient simulation. The first tone following . HB is used to determine the period for the transient simulation. For multi-tone HB simulation, it should be set to the frequency that produces the most nonlinear response by the circuit. When tahb = 2, the DC op is used as an initial guess | 1       |

Table 2-13. Options for HB.

| Option    | Description   | Default  |
|-----------|---|--|
| VOLTLIM   | This flag sets voltage limiting for HB. During the initial guess calculation, which normally uses transient simulation, the voltage limiting flag is determined by .options device voltlim. During the HB phase, the voltage limiting flag is determined by .options hbint voltlim. | 1  |
| INTMODMAX | The maximum intermodulation product order used in the spectrum.   | the largest<br>value in the<br>NUMFREQ<br>list.              |
| NUMTPTS   | Number of time points in the output   | The total number of frequencies (positive, negative and DC). |

### 2.1.25.17. OPTIONS DIST (Parallel Distribution Options)

The parameters listed in Table 2-14 give the available options for controlling the parallel distribution used in Xyce. There are three choices for distribution strategy.

The default distribution strategy is "first-come, first-served" (STRATEGY=0), which divides the devices found in the netlist into equal sized groups (in the order they are parsed) and distributes a group to each processor. This does not take into account the connectivity of the circuit or balance device model computation, and therefore can exhibit parallel imbalance for post-layout circuits that have a substantial portion of parasitic devices.

The "flat round-robin" strategy (STRATEGY=1) will generate the same distribution as the default strategy, but every parallel processor will participate in reading its portion of the netlist. This strategy provides a more scalable setup than the default strategy, but can only be applied to flattened (non-hierarchical) netlists.

The "device balanced" strategy (STRATEGY=2) will evenly divide each of the device types over the number of parallel processors, so each processor will have a balanced number of each model type. This allieviates the parallel imbalance in the device model computation that can be experienced with post-layout circuits. However, it does not take into account the circuit connectivity, so the communication will not be minimized by this strategy.

**Table 2-14. Options for Parallel Distribution.** 

| Option   | Description                           | Default |
|----------|---------------------------------------|---------|
|          | Parallel device distribution strategy |         |
| STRATEGY | • 0 (First-Come, First-Served)        |         |
|          | • 1 (Flat Round-Robin)                | 0       |
|          | • 2 (Device Balanced)                 |         |
|          |                                       |         |

## 2.1.25.18. OPTIONS FFT (FFT Options)

The parameters listed in Table 2-15 give the available options for controlling all of the .FFT statements in a given Xyce netlist.

If FFT\_ACCURATE is set to 1 (true), which is the default, then Xyce will insert breakpoints at the sample times requested by the collection of .FFT lines in the netlist. This has been found to improve the accuracy of the .FFT analyses, at the possible expense of simulation speed. If FFT\_ACCURATE is set to 0 (false), then interpolation is used to determine the output variable values at the specified sample times. If the <code>-remeasure</code> command line option is used to recalculate the .MEASURE FFT and/or .FFT statements for a .TRAN analysis, then FFT\_ACCURATE is set to 0 during the re-measure operation. Finally, if .OPTIONS OUTPUT INITIAL\_INTERVAL is used in the netlist then .OPTIONS FFT FFT\_ACCURATE will also be set to 0.

If FFTOUT is set to 1 then additional metrics are output to both stdout and the <netlistName>.fft0 file for each .FFT line. In addition a sorted list of the 30 largest harmonics is output to stdout. Those additional metrics are as follows, where Section 2.1.8.3 provides detailed definitions for these metrics:

- Effective Number of Bits (ENOB)
- Spurious Free Dynamic Range (SFDR)
- Signal to Noise Ratio (SNR)
- Signal to Noise-and-Distortion Ratio (SNDR)
- Total Harmonic Distorion (THD)

The setting for FFT\_MODE is used to control whether the Xyce FFT processing and output are more compatible with HSPICE (0) or Spectre (1). This setting affects the format of the window functions, the conversion from two-sided to one-sided results, and whether the default output for the magnitude values is normalized, or not. Section 2.1.8.1 gives more details.

Table 2-15. Options for FFT.

| Option       | Description   | Default  |
|--------------|---|----------|
| FFT_ACCURATE | Insert breakpoints at the sample times requested by the collection of .FFT lines in the netlist | 1 (true) |

Table 2-15. Options for FFT.

| Option   | Description  | Default   |
|----------|--|-----------|
| FFTOUT   | Output additional metrics (ENOB, SFDR, SNR, SNDR and THD) and a sorted list of the 30 largest harmonics for each .FFT line | 0 (false) |
| FFT_MODE | Controls whether the FFT calculations and output format are more compatible with HSPICE (0) or Spectre (1)                 | 0         |

#### 2.1.25.19. OPTIONS MEASURE (Measure Options)

The parameters listed in Table 2-16 give the available options for controlling all of the .MEASURE statements in a given Xyce netlist. The MEASDGT, MEASFAIL and MEASOUT options are included for HSPICE compatibility.

If given in the netlist, the setting for MEASOUT controls whether the .mt# (or .ms# or .ma#) files are made (1) or not (0). The MEASOUT setting takes precedence over the MEASPRINT setting (which is a Xyce-specific option) if both are given in the netlist. See Section 2.1.18.7 for more details then on how the MEASPRINT option interacts with the individual .MEASURE statements and the  $\neg$ remeasure command line option.

If given in the netlist, the setting for the MEASDGT overrides the PRECISION qualifiers given on individual .MEASURE lines. The default value for the MEASDGT option is different from in HSPICE.

The Xyce behavior for failed measures can be controlled via the MEASFAIL and DEFAULT\_VAL options, as well as with the DEFAULT\_VAL qualifiers on individual .MEASURE lines. The order of precedence (from high-to-low) is the MEASFAIL option, the DEFAULT\_VAL option, and the DEFAULT\_VAL qualifier on individual .MEASURE lines. If the MEASFAIL option is given and set equal to 0 then Xyce outputs "0" in the .mt# ( or .ms# or .ma#) files for a failed measure. If the MEASFAIL option is given and set equal to 1 (or any other non-zero value) then Xyce outputs "FAILED" in the .mt# ( or .ms# or .ma#) files for a failed measure. If given in the netlist, the setting for the DEFAULT\_VAL option overrides the DEFAULT\_VAL qualifiers given on individual .MEASURE lines. The DEFAULT\_VAL option and the DEFAULT\_VAL qualifiers can be set to any real number. For all of these cases, Xyce will print "FAILED" to the standard output for a failed measure. As a final note, the FOUR measure is a special case since it produces multiline output. Failed FOUR measures will be reported as "FAILED" in the .mt# ( or .ms# or .ma#) files, irrespective of the various MEASFAIL and DEFAULT\_VAL settings.

The USE\_CONT\_FILES option controls whether each AC\_CONT, DC\_CONT, NOISE\_CONT or TRAN\_CONT mode measure uses a separate output file for its results, or not. Section 2.1.19.1 provides more details and an example netlist for this options setting.

Table 2-16. Options for MEASURE.

| Option      | Description  | Default |
|-------------|--|---------|
| DEFAULT_VAL | Default value for "failed measures" in the .mt# ( or .ms# or .ma#) files.  | -1      |
| MEASDGT     | Precision for all .MEASURE statements. This value applies to the output to both the .mt# ( or .ms# or .ma#) files and the standard output. | 6       |

Table 2-16. Options for MEASURE.

| Option         | Description   | Default  |
|----------------|---|----------|
| MEASFAIL       | Specify output format for failed measures   | 1        |
| MEASOUT        | Control whether the .mt0 file is made or not  | 1        |
| MEASPRINT      | <ul> <li>Measure Output</li> <li>ALL (Output measure information to both file(s) and stdout)</li> <li>STDOUT (Output measure information to stdout only)</li> <li>NONE (Suppress all measure output)</li> </ul> | ALL      |
| USE_CONT_FILES | Specifies whether "continuous" mode measures use separate output files for each such measure  | 1 (TRUE) |

# 2.1.25.20. OPTIONS PARSER (Parser Options)

The parameter listed in Table 2-17 gives the available option for netlist parsing.

Table 2-17. Options for Parsing.

| Option        | Description  | Default |
|---------------|--|---------|
| MODEL_BINNING | Enable model binning during netlist parsing. See Section 2.1.21 for more details on how model binning works in Xyce. | TRUE    |

## 2.1.26. . PARAM (Parameter)

User defined parameter that can be used in expressions throughout the netlist.

General Form .PARAM [<name>=<value>] \*

### Examples .PARAM A\_Param=1K

.PARAM B\_Param={A\_Param\*3.1415926535}

# Arguments and Options

name

value

The name of a parameter and its value. The value may be an expression.

#### **Comments**

Parameters defined using .PARAM only have a few restrictions on their usage. In earlier versions of Xyce they were handled as constants that were evaluated during parsing. This is no longer the case, and parameters can now have their values change throughout the calculation. A .PARAM defined in the top level netlist is equivalent to a .GLOBAL\_PARAM, and they can be combined as needed. Thus, you may use parameters defined by .PARAM in expressions used to define global parameters, and you may also use global parameters in .PARAM definitions.

It is legal for parameters to depend on special variables such as TIME, FREQ, TEMP and VT variables. However, it is not legal for parameters to depend on solution variables such as voltage nodes or independent source currents.

Parameters defined using .PARAM can be modified directly by various analyses, such as .DC, .STEP, .SAMPLING and .EMBEDDEDSAMPLING, subject to scoping rules.

To load an external data file with time voltage pairs of data on each line into a global parameter, use this syntax:

```
.GLOBAL_PARAM extdata = {tablefile("filename")}
or
.GLOBAL_PARAM extdata = {table("filename")}
```

where filename would be the name of the file to load. Other interpolators that can read in a data table from a file include fasttable, spline, akima, cubic, wodicka and bli. See 2.2 for further information.

There are several reserved words that may not be used as names for parameters. These reserved words are:

- Time
- Freq
- Hertz
- Vt

- Temp
- Temper
- GMIN

The scoping rules for parameters are:

- If a . PARAM, statement is included in the main circuit netlist, then it is accessible from the main circuit and all subcircuits.
- . PARAM statements defined within a subcircuit are scoped to that subcircuit definition. So, their parameters are only accessible within that subcircuit definition, as well as within "nested subcircuits" also defined within that subcircuit definition.
- Parameters defined via .PARAM statements can be modified by the various UQ analysis techniques (.STEP, .SAMPLING, etc) but this only works for .PARAM that have been defined in the top level netlist. Parameters defined inside of subcircuits cannot be modified directly by these analyes, but they can be modified indirectly via dependence on other globally scoped parameter.

Additional illustative examples of scoping are given in the "Working with Subcircuits and Models" section of the Xyce Users' Guide [1] .

## 2.1.27. . PCE (Fully Intrusive Polynomial Chaos Expansion (PCE) Analysis)

Calculates a fully intrusive Polynommial Chaos Expansion (PCE) analysis (for .DC or .TRAN only) to propagate uncertainty from a set of uncertain inputs to uncertain outputs. This involves evaluating the circuit at a set of parameter values corresponding to quadrature points used by the PCE algorithm. The loop over parameter values happens at the inner-most part of the calculation, so all samples are propagated simultaneously.

This fully-intrusive form of PCE is an experimental analysis method. Non-intrusive methods of PCE are also available in Xyce and will usually be a better choice. The non-intrusive methods are used in combination with .SAMPLING and/or .EMBEDDEDSAMPLING. Of those other methods, the behavior of .PCE most closely resembles that of .EMBEDDEDSAMPLING with projection\_pce=true.

```
General Form
               .PCE
               + param=<parameter name>, [parameter name] *
              + type=<parameter type>, [parameter type] *
              + means=<mean>, [mean] *
              + std_deviations=<standard deviation>, [standard
              deviation] *
              + lower_bounds=<lower bound>, [lower bound] *
              + upper_bounds=<upper bound>, [upper bound] *
              + alpha=<alpha>, [alpha] *
              + beta=<beta>,[beta] *
Examples
               .PCE
               + param=R1
              + type=normal
              + means=3K
              + std_deviations=1K
               .PCE
              + param=R1,R2
              + type=uniform, uniform
              + lower_bounds=1K,2K
              + upper_bounds=5K,6K
               .PCE useExpr=true
```

# Arguments and Options

param

.options PCES

+ OUTPUTS={R1:R}, {V(1)}

Names of the parameters to be sampled. This may be any of the parameters that are valid for <code>.STEP</code>, including device instance, device model, or global parameters. If more than one parameter, then specify as a comma-separated list.

#### type

Distribution type for each parameter. This may be uniform, normal or gamma. If more than one parameter, then specify as a comma-separated list.

#### means

If using normal distributions, the mean for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

#### std\_deviations

If using normal distributions, the standard deviation for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

#### lower bounds

If using uniform distributions, the lower bound must be specified. This is optional for normal distributions. If used with normal distributions, may alter the mean and standard deviation. If more than one parameter, then specify as a comma-separated list.

#### upper\_bounds

If using uniform distributions, the upper bound must be specified. This is optional for normal distributions. If used with normal distributions, may alter the mean and standard deviation. If more than one parameter, then specify as a comma-separated list.

#### alpha

If using gamma distributions, the alpha value for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

#### beta

If using gamma distributions, the beta value for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

#### useExpr

If this argument is set to true, then the sampling algorithm will set up random inputs from expression operators such as AGAUSS and AUNIF. In this case it will also ignore the list of parameters on the .PCE command line. For a complete description of expression-based random operators, see the expression documentation in section 2.2.

#### **Comments**

In addition to the .PCE command, this analysis requires a .options PCES command as well. The .PCE command specifies parameters and their attributes, either using the useExpr option, or with comma-separated lists. The .options PCES command specifies the outputs for which to compute statistics. To see the details of the .options PCES command, see table 2-11.

On the <code>.PCE</code> command line, if not using <code>useExpr</code>, parameters and their attributes must be specified using comma-separated lists. The comma-separated lists must all be the same length.

The .PRINT PCE command provides output based on the contents of those print-lines, and also the OUTPUT arguments on the .OPTIONS PCES line.

If the OUTPUT\_SAMPLE\_STATS argument on a .PRINT PCE line is set to "true" then the statistics for the MEAN, MEANPLUS, MEANMINUS, STDDEV and VARIANCE will be output for each variable in the OUTPUT argument. If the OUTPUT\_ALL\_SAMPLES argument on a .PRINT PCE line is set to "true" then the values of all quadrature points, for each variable requested in the OUTPUTS argument, will be output.

## 2.1.28. . PREPROCESS REPLACEGROUND (Ground Synonym)

The purpose of ground synonym replacement is to treat nodes with the names GND, GND!, GROUND or any capital/lowercase variant thereof as synonyms for node 0. The general invocation is

General Form .PREPROCESS REPLACEGROUND <bool>

**Arguments and Options** 

bool

If TRUE, Xyce will treat all instances of GND, GND!, GROUND, or any capital/lowercase variant thereof, as synonyms for node 0. If FALSE, Xyce will consider each term as a separate node. Only one .PREPROCESS REPLACEGROUND statement is permissible in a given netlist file.

## 2.1.29. . PREPROCESS REMOVEUNUSED (Removal of Unused Components)

If a given netlist file contains devices whose terminals are all connected to the same node (e.g., R2 1 1 1M), it may be desirable to remove such components from the netlist before simulation begins. This is the purpose of the command

General Form .PREPROCESS REMOVEUNUSED [<value>]

# Arguments and Options

value

is a list of components separated by commas. The allowed values are

| С | Capacitor                  |
|---|----------------------------|
| D | Diode                      |
| I | Independent Current Source |
| L | Inductor                   |
| М | MOSFET                     |
| Q | BJT                        |
| R | Resistor                   |
| V | Independent Voltage Source |

### **Examples**

.PREPROCESS REMOVEUNUSED R,C

.PREPROCESS will attempt to search for all resistors and capacitors in a given netlist file whose individual device terminals are connected to the same node and remove these components from the netlist before simulation ensues. A list of components that are supported for removal is given above. Note that for MOSFETS and BJTs, three terminals on each device (the gate, source, and drain in the case of a MOSFET and the collector, base, and emitter in the case of a BJT) must be the same for the device to be removed from the netlist. As before, only one .PREPROCESS REMOVEUNUSED line is allowed in a given netlist file.

## 2.1.30. . PREPROCESS ADDRESISTORS (Adding Resistors to Dangling Nodes)

We refer to a *dangling node* as a circuit node in one of the following two scenarios: either the node is connected to only one device terminal, and/or the node has no DC path to ground. If several such nodes exist in a given netlist file, it may be desirable to automatically append a resistor of a specified value between the dangling node and ground. To add resistors to nodes which are connected to only one device terminal, one may use the command

| Gen | eral | Form |
|-----|------|------|
|     |      |      |

.PREPROCESS ADDRESISTORS ONETERMINAL <value>

# Arguments and Options

value

is the value of the resistor to be placed between nodes with only one device terminal connection and ground. For instance, the command

#### **Examples**

.PREPROCESS ADDRESISTORS ONETERMINAL 1G

will add resistors of value 1G between ground and nodes with only one device terminal connection and ground. The command

### **Examples**

.PREPROCESS ADDRESISTORS NODCPATH <value>

acts similarly, adding resistors of value <VALUE> between ground and all nodes which have no DC path to ground.

The .PREPROCESS ADDRESISTORS command is functionally different from either of the prior .PREPROCESS commands in the following way: while the other commands augment the netlist file for the current simulation, a .PREPROCESS ADDRESISTORS statement creates an auxiliary netlist file which explicitly contains a set of resistors that connect dangling nodes to ground. If the original netlist file containing a .PREPROCESS ADDRESISTORS statement is called filename, invoking Xyce on this file will produce a file filename\_xyce.cir which contains the resistors that connect dangling nodes to ground. One can then run Xyce on this file to run a simulation in which the dangling nodes are tied to ground. Note that, in the original run on the file filename\_xyce.cir, but this simulation will not include the effects of adding resistors between the dangling nodes and ground. Refer to the Xyce Users' Guide [1] for more detailed examples on the use of .PREPROCESS ADDRESISTOR statements.

Note that it is possible for a node to have one device terminal connection and, simultaneously, have no DC path to ground. In this case, if both a <code>ONETERMINAL</code> and <code>NODCPATH</code> command are invoked, only the resistor for the <code>ONETERMINAL</code> connection is added to the netlist; the <code>NODCPATH</code> connection is omitted.

As before, each netlist file is allowed to contain only one .PREPROCESS ADDRESISTORS ONETERMINAL and one .PREPROCESS ADDRESISTORS NODCPATH line each, or else Xyce will exit in error.

## 2.1.31. . PRINT (Print output)

Send analysis results to an output file.

General Form

Xyce allows multiple output files to be created during the run and supports several options for each.

.PRINT <print type> [FILE=<output filename>]

```
+ [FORMAT=<STD|NOINDEX|PROBE|TECPLOT|RAW|CSV|GNUPLOT|SPLOT>]
              + [WIDTH=<print field width>]
              + [PRECISION=<floating point output precision>]
              + [FILTER=<absolute value below which a number outputs as 0.0>]
              + [DELIMITER=<TAB|COMMA>] [TIMESCALEFACTOR=<real scale factor>]
              + [OUTPUT_SAMPLE_STATS=<boolean>] [OUTPUT_ALL_SAMPLES=<boolean>]
              + <output variable> [output variable] *
Examples
              .print tran format=tecplot V(1) I(Vsrc) \{V(1) * (I(Vsrc) * * 2.0)\}
              .PRINT TRAN FORMAT=PROBE FILE=foobar.csd V(1) {abs(V(1))-5.0}
              .PRINT DC FILE=foobar.txt WIDTH=19 PRECISION=15 FILTER=1.0e-10
              + I(VSOURCE5) I(VSOURCE6)
              .print tran FORMAT=RAW V(1) I(Vsrc)
              R1 1 0 100
              X1 1 2 3 MySubcircuit
              V1 3 0 1V
              .SUBCKT MYSUBCIRCUIT 1 2 3
              R1 1 2 100K
              R2 2 4 50K
              R3 4 3 1K
              .ENDS
              .PRINT DC V(X1:4) V(2) I(V1)
```

# Arguments and Options

```
print type
```

A print type is the name of an analysis, one of the analysis specific print subtypes, or a specialized output command.

| Analysis                    | Print Type | Description  |  |
|-----------------------------|------------|--|--|
| . AC                        | AC         | Sets default variable list and formats for print subtypes    |  |
| .AC                         | AC_IC      | Overrides variable list and format for AC initial conditions |  |
| .DC                         | DC         |  |  |
| .EMBDEDDEDSAMPLING          | ES         |  |  |
| .HB                         | НВ         |  |  |
| . HB                        | HB_FD      | Overrides variable list and format for HB frequency domain   |  |
| . НВ                        | HB_IC      | Overrides variable list and format for HB initial conditions |  |
| .HB                         | HB_STARTUP | Overrides variable list and format for HB start up           |  |
| .НВ                         | HB_TD      | Overrides variable list and format for HB time domain        |  |
| .NOISE                      | Noise      | Outputs Noise spectral density curves                        |  |
| .TRAN                       | TRAN       |  |  |
| Specialized Output Commands |            |  |  |
| Homotopy                    | НОМОТОРУ   | Sets variable list and format for homotopy                   |  |
| .SENS                       | SENS       | Sets variable list and format for sensitivity                |  |

A netlist may contain many .PRINT commands, but only commands with analysis types which are appropriate for the analysis being performed are processed. This feature allows you to generate multiple formats and variable sets in a single analysis run.

For analysis types that generate multiple output files, the print subtype allows you to specify variables and output parameters for each of those output files. If there is no .PRINT <subtype> provided in the net list, the variables and parameters from the analysis type will be used.

## FORMAT=<STD | NOINDEX | PROBE | TECPLOT | RAW | CSV | GNUPLOT | SPLOT>

The output format may be specified using the FORMAT option. The STD format outputs the data divided up into data columns. The NOINDEX format is the same as the STD format except that the index column is omitted. The PROBE format specifies that the output should be formatted to be compatible with the PSpice Probe plotting utility. The TECPLOT format specifies that the output should be formatted to be compatible with the Tecplot plotting program. The RAW format specifies that the output should comply with the SPICE binary rawfile format. The -a command line option, in conjunction with FORMAT=RAW on the .PRINT line, can then be used to

output an ASCII rawfile. The CSV format specifies that the output file should be a comma-separated value file with a header indicating the variables printed in the file. It is similar to, but not identical to using DELIMITER=COMMA; the latter will also print a footer that is not compatible with most software that requires CSV format. The GNUPLOT (or SPLOT) format is the same as the STD format except that if . STEP is used then two (or one) blank lines are inserted before the data for steps 1,2,3,... where the first step is step 0. The SPLOT format is useful for when the "splot" command in gnuplot is used to produce 3D perspective plots.

#### FILE=<output filename>

Specifies the name of the file to which the output will be written. See the "Results Output and Evaluation Options" section of the Xyce Users' Guide [1] for more information on how this feature works for analysis types (e.g., AC and HB) that can produce multiple output files.

#### WIDTH=<print field width>

Controls the output width used in formatting the output.

#### PRECISION=<floating point precision>

Number of floating point digits past the decimal for output data.

#### FILTER=<filter floor value>

Used to specify the absolute value below which output variables will be printed as 0.0.

## DELIMITER=<TAB|COMMA>

Used to specify an alternate delimiter in the STD or NOINDEX format output.

#### TIMESCALEFACTOR=<real scale factor>

Specify a constant scaling factor for time. Time is normally printed in units of seconds, but if one would like the units to be milliseconds, then set TIMESCALEFACTOR=1000.

#### OUTPUT SAMPLE STATS=<boolean>

Output the sample statistics for an EMBEDDEDSAMPLING analysis. This argument is only supported for <code>.PRINT</code> ES. Its default value is true. Section 2.1.5 has more details.

## OUTPUT\_ALL\_SAMPLES=<boolean>

Output all of the sample values for an EMBEDDEDSAMPLING analysis. This argument is only supported for <code>.PRINT</code> ES. Its default value is false. Section 2.1.5 has more details.

## <output variable>

Following the analysis type and other options is a list of output variables. There is no upper bound on the number of output variables. The output is divided up into data columns and output according to any specified options (see options given above). Output variables can be specified as:

• V (<circuit node>) to output the voltage at <circuit node>

- V(<circuit node>, <circuit node>) to output the voltage difference between the first <circuit node> and second <circuit node>
- I (<device>) to output current through a two terminal device
- I<lead abbreviation>(<device>) to output current into a particular lead of a three or more terminal device (see the Comments, below, for details)
- P (<device>) or W (<device>) to output the power dissipated/generated in a device. At this time, not all devices support power calculations. In addition, the results for semiconductor devices (D, J, M, Q and Z devices) and the lossless transmission device (T device) may differ from other simulators. Consult the Features Supported by Xyce Device Models table in section 2.3 and the individual sections on each device for more details. Finally, power calculations are not supported for any devices for .AC and .NOISE analyses.
- N (<device internal variable>) to output a specific device's internal variable. (The comments section below has more detail on this syntax.)
- {expression} to output an expression
- <device>:<parameter> to output a device parameter
- <model>:<parameter> to output a model parameter

When the analysis type is AC, HB or Noise, additional output variable formats are available:

- VR (<circuit node>) to output the real component of voltage response at a point in the circuit
- VI (<circuit node>) to output the imaginary component of voltage response at a point in the circuit
- VM(<circuit node>) to output the magnitude of voltage response
- VP (<circuit node>) to output the phase of voltage response in degrees
- VDB (<circuit node>) to output the magnitude of voltage response in decibels.
- VR (<circuit node>, <circuit node>) to output the real component of voltage response between two nodes in the circuit
- VI (<circuit node>, <circuit node>) to output the imaginary component of voltage response between two nodes in the circuit
- VM(<circuit node>, <circuit node>) to output the magnitude of voltage response between two nodes in the circuit
- VP (<circuit node>, <circuit node>) to output the phase of

voltage response between two nodes in the circuit in degrees

- VDB (<circuit node>, <circuit node>) to output the magnitude of voltage response between two nodes in the circuit, in decibels
- IR (<device>) to output the real component of the current through a two terminal device
- II (<device>) to output the imaginary component of the current through a two terminal device
- IM(<device>) to output the magnitude of the current through a two terminal device
- IP (<device>) to output the phase of the current through a two terminal device in degrees
- IDB (<device>) to output the magnitude of the current through a two terminal device in decibels.

In AC and Noise analyses, outputting a voltage node without any of these optional designators results in output of the real and imaginary parts of the signal. Note that under AC and Noise analyses, current variables are only supported for devices that have "branch currents" that are part of the solution vector. This includes the V, E, H and L devices. It also includes the voltage-form of the B device.

Note that when using the variable list for time domain output, usage of frequency domain functions like VDB can result in -Inf output being written to the output file. This is easily solved by defining the time domain equivalent command to specify the correct output for time domain data.

Further explanation of the current specifications is given in comments section below.

When a .LIN analysis is done then additional output variable formats are available via the .PRINT AC line, where <index1> and <index2> must both be greater than 0 and also both less than or equal to the number of ports in the netlist:

- SR(<index1>, <index2>) to output the real component of an S-parameter
- SI (<index1>, <index2>) to output the imaginary component of an S-parameter
- SM(<index1>, <index2>) to output the magnitude of an S-parameter
- SP (<index1>, <index2>) to output the phase of an S-parameter in degrees
- SDB (<index1>, <index2>) to output the magnitude of an S-parameter in decibels.
- YR (<index1>, <index2>) to output the real component of a Y-parameter

- YI (<index1>, <index2>) to output the imaginary component of a Y-parameter
- YM(<index1>,<index2>) to output the magnitude of a Y-parameter
- YP (<index1>, <index2>) to output the phase of a Y-parameter in degrees
- YDB (<index1>, <index2>) to output the magnitude of a Y-parameter in decibels.
- ZR(<index1>,<index2>) to output the real component of a Z-parameter
- ZI (<index1>, <index2>) to output the imaginary component of a Z-parameter
- ZM(<index1>,<index2>) to output the magnitude of a Z-parameter
- ZP (<index1>, <index2>) to output the phase of a Z-parameter in degrees
- ZDB (<index1>, <index2>) to output the magnitude of a Z-parameter in decibels.

When the analysis type is Noise, additional output variable formats are available via the .PRINT NOISE line for devices that support stationary noise.

- INOISE to output the input noise contributions
- ONOISE to output the output noise contributions
- DNI (<deviceName>) to output the input noise contribution from device <deviceName>
- DNI (<deviceName>, <noiseSource>) to output the input noise contribution from source <noiseSource> for device <deviceName>
- DNO (<deviceName>) to output the output noise contribution from device <deviceName>
- DNO (<deviceName>, <noiseSource>) to output the output noise contribution from source <noiseSource> for device <deviceName>

#### **Comments**

- Currents are positive flowing from node 1 to node 2 for two node devices, and currents are positive flowing into a particular lead for multi-terminal devices.
- <circuit node> is simply the name of any node in your top-level circuit, or <subcircuit name>: <node> to reference nodes that are internal to a subcircuit.
- <device> is the name of any device in your top-level circuit, or
   <subcircuit name>:<device> to reference devices that are internal to a subcircuit.

- <lead abbreviation> is a single character designator for individual leads on a device with three or more leads. For bipolar transistors these are: c (collector), b (base), e (emitter), and s (substrate). For mosfets, lead abbreviations are: d (drain), g (gate), s (source), and b (bulk). SOI transistors have: d, g, s, e (bulk), and b (body). For PDE devices, the nodes are numbered according to the order they appear, so lead currents are referenced like I1(<device>), I2(<device>), etc. In Xyce, a .PRINT line request like I (Q1) is a parsing error for a multi-terminal device. Instead, an explicit lead current designator like IC (Q1) must be used.
- The "lead current" method of printing from devices in Xyce is done at a low level with special code added to each device; the method is therefore only supported in specific devices that have this extra code. So, if .PRINT I(Y) does not work, for a device called Y, then you will need to attach an ammeter (zero-volt voltage source) in series with that device and print the ammeter's current instead.
- Lead currents of subcircuit ports are not supported. However, access is provided via specific node names (e.g., X1:internalNodeName) or specific devices (e.g., X1:V3) inside the subcircuit.
- For STD formatted output, the values of the output variables are output as a series of columns (one for each output variable).
- When the command line option -r <raw-file-name> is used, all of the output is diverted to the *raw-file-name* file as a concatenation of the plots, and each plot includes all of the variables of the circuit instead of the variable list(s) given on the .PRINT lines in the netlist. Using the -a options in conjunction with the -r option results in a raw file that is output all in ASCII characters.
- Any output going to the same file from one simulation of Xyce results in the concatenation of output. However, if a simulation is re-run then the original output will we over-written.
- During analysis a number of output files may be generated. The selection of which files are created depends on a variety of factors, most obvious of which is the .PRINT command. See section 2.1 for more details.
- Frequency domain values are output as complex values for Raw, TecPlot and Probe formats when a complex variable is printed. For STD and CSV formats, the output appears in two columns, the real part followed by the imaginary part. The print variables VR, VI, VM, VDB and VP print the scalar values for the real part, imaginary part, magnitude, magnitude in decibels, and phase, respectively.
- When outputting a device or model parameter, it is usually necessary to specify both the device name and the parameter name, separated by a colon. For example, the saturation current of a diode model DMOD would be requested as DMOD: IS. Section 2.1.31.12 on "Device Parameters and Internal Variables" below gives more details and provides an example.

- The N() syntax is used to access internal solution variables that are not normally visible from the netlist, such as voltages on internal nodes and/or branch currents within a given device. The internal solution variables for each Xyce device are not given in the Reference Guide sections on those devices. However, if the user runs Xyce -namesfile <filename> <netlist> then Xyce will output into the first filename a list of all solution variables generated by that netlist. Section 2.1.31.12 on "Device Parameters and Internal Variables" below gives more details and provides an example.
- The DNI() and DNO() syntax is used to print out the individual input and output noise contributions for each noise source within a device. The user can get a listing of the noise source names for each device in a netlist by running Xyce -noise\_names\_file <filename> <netlist>. The Xyce Users' Guide [1] provides an example.
- If multiple .PRINT lines are given for the same analysis type, the same output file name, and the same format, the variable lists of all matching .PRINT lines are merged together in the order found, and the resulting output is the same as if all the print line variable lists had been specified on a single .PRINT line.
- Attempting to specify multiple .PRINT lines for the same analysis type to the same file with different specifications of FORMAT is an error.
- Xyce should emit a warning or error message, similar to "Could not open filename" if: 1) the name of the output file is actually a directory name; or 2) the output file is in a subdirectory that does not already exist. Xyce will not create new subdirectories.
- The output filename specified with the -r command line option, to produce raw file output, should take precedence over a FILE= parameter specified on a .PRINT line.
- The print statements for some analysis types could result in multiple output files. For example, .PRINT HB will produce both frequency- and time-domain output, and place these in different files. The default name of these files is the name of the netlist followed by a data type suffix, followed by a format-specific extension.

In Xyce, if a FILE option is given to such a print statement, only the "primary" data for that analysis type is sent to the named file. The secondary data is still sent to the default file name. This behavior may be subject to change in future releases.

For analysis types that can produce multiple files, special .PRINT lines have been provided to allow the user to control the handling of the additional files. These additional print line specifiers are enumerated in the analysis-specific sections below.

If one desires that all outputs for a given analysis type be given user-defined file names, it is necessary to use additional print lines with additional FILE options. For example, if one uses a FILE option to a .PRINT HB line, only frequency-domain data will be sent to the named file. To redirect the

time-domain data to a file with a user-defined name, add a .PRINT HB\_TD line. See the individual analysis types below for details of what additional print statements are available.

## 2.1.31.1. Print AC Analysis

AC Analysis generates two output files, the primary output is in the frequency domain and the initial conditions output is in the time domain.

Note that when using the .PRINT AC to create the variable list for DC type output, usage of frequency domain functions like VDB can result in -Inf output being written to the output file. This is easily solved by defining a .PRINT AC\_IC command to specify the correct output for initial condition data.

Homotopy output can also be generated.

Table 2-18. Print AC Analysis Type

| Trigger                                    | Files                       | Columns/Description           |
|--|-----------------------------|-------------------------------|
| .PRINT AC                                  | circuit-file.FD.prn         | INDEX FREQ                    |
| .PRINT AC FORMAT=GNUPLOT                   | circuit-file.FD.prn         | INDEX FREQ                    |
| .PRINT AC FORMAT=SPLOT                     | circuit-file.FD.prn         | INDEX FREQ                    |
| .PRINT AC FORMAT=NOINDEX                   | circuit-file.FD.prn         | FREQ                          |
| .PRINT AC FORMAT=CSV                       | circuit-file.FD.csv         | FREQ                          |
| .PRINT AC FORMAT=RAW                       | circuit-file.raw            | FREQ                          |
| Xyce -a<br>.PRINT AC FORMAT=RAW            | circuit-file.xaw            | FREQ                          |
| .PRINT AC FORMAT=TECPLOT                   | circuit-file.FD.dat         | FREQ                          |
| .PRINT AC FORMAT=PROBE                     | circuit-file.csd            | -                             |
| Add . OP To Net                            | list To Enable AC_IC Output |                               |
| .PRINT AC_IC                               | circuit-file.TD.prn         | INDEX TIME                    |
| .PRINT AC_IC FORMAT=GNUPLOT                | circuit-file.TD.prn         | INDEX TIME                    |
| .PRINT AC_IC FORMAT=SPLOT                  | circuit-file.TD.prn         | INDEX TIME                    |
| .PRINT AC_IC FORMAT=NOINDEX                | circuit-file.TD.prn         | TIME                          |
| .PRINT AC_IC FORMAT=CSV                    | circuit-file.TD.csv         | TIME                          |
| .PRINT AC_IC FORMAT=RAW                    | circuit-file.raw            | TIME                          |
| <pre>Xyce -a .PRINT AC_IC FORMAT=RAW</pre> | circuit-file.raw            | TIME                          |
| .PRINT AC_IC FORMAT=TECPLOT                | circuit-file.TD.dat         | TIME                          |
| .PRINT AC_IC FORMAT=PROBE                  | circuit-file.TD.csd         | -                             |
| Command Line Raw Override Output           |                             |                               |
| Xyce -r raw-file-name                      | raw-file-name               | All circuit variables printed |
| Xyce -r raw-file-name -a                   | raw-file-name               | All circuit variables printed |

Table 2-18. Print AC Analysis Type

| Trigger   | Files                       | Columns/Description  |
|---|-----------------------------|----------------------|
|   | Additional Output Available |                      |
| .OP   | log file                    | Operating point data |
| .SENS<br>.PRINT SENS  | Se                          | ee Print Sensitivity |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY</method> | Se                          | ee Print Homotopy    |

# 2.1.31.2. Print DC Analysis

DC Analysis generates output based on the format specified by the .PRINT command.

Homotopy and sensitivity output can also be generated.

Table 2-19. Print DC Analysis Type

| Trigger   | Files                            | Columns/Description   |
|---|----------------------------------|-----------------------|
| .PRINT DC   | circuit-file.prn                 | INDEX                 |
| .PRINT DC FORMAT=GNUPLOT  | <i>circuit-file</i> .prn         | INDEX                 |
| .PRINT DC FORMAT=SPLOT  | <i>circuit-file</i> .prn         | INDEX                 |
| .PRINT DC FORMAT=NOINDEX  | <i>circuit-file</i> .prn         | _                     |
| .PRINT DC FORMAT=CSV  | circuit-file.csv                 |                       |
| .PRINT DC FORMAT=RAW  | circuit-file.raw                 | _                     |
| Xyce -a<br>.PRINT DC FORMAT=RAW                                 | circuit-file.raw                 | _                     |
| .PRINT DC FORMAT=TECPLOT  | <i>circuit-file</i> .dat         |                       |
| .PRINT DC FORMAT=PROBE  | circuit-file.csd                 | _                     |
|   | Command Line Raw Override Output |                       |
| Xyce -r raw-file-name   | raw-file-name                    | All circuit variables |
| Xyce -r raw-file-name -a  | raw-file-name                    | All circuit variables |
|   | Additional Output Available      |                       |
| .0P   | log file                         | Operating point data  |
| .SENS<br>.PRINT SENS  | see Print Sensitivity            |                       |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY</method> | see I                            | Print Homotopy        |

## 2.1.31.3. Print Harmonic Balance Analysis

HB Analysis generates one output file in the frequency domain and one in the time domain based on the format specified by the .PRINT command. Additional startup and initial conditions output can be generated based on .OPTIONS commands.

Note that when using the .PRINT HB to create the variable list for time domain output, usage of frequency domain functions like VDB can result in -Inf output being written to the output file. This is easily solved by defining a .PRINT HB\_TD, .PRINT HB\_IC and .PRINT HB\_STARTUP commands to specify the correct output for the time domain data.

If .STEP is used with HB then the Initial Condition (IC) data will initially be output to a "tmp file" (e.g., <netlist-name>.hb\_ic.prn.tmp). If that IC data meets the required tolerance then it will be copied to the end of the <netlist-name>.hb\_ic.prn file, and the tmp file will be deleted.

Homotopy output can also be generated.

Table 2-20. Print HB Analysis Type

|                             | · · · · · · · · · · · · · · · · · · ·  |  |
|-----------------------------|--|--|
| Trigger                     | Files  | Columns/Description                    |
| .PRINT HB                   | <i>circuit-file</i> .HB.TD.prn<br><i>circuit-file</i> .HB.FD.prn<br><i>circuit-file</i> .hb_ic.prn | INDEX TIME<br>INDEX FREQ<br>INDEX TIME |
| .PRINT HB FORMAT=GNUPLOT    | <i>circuit-file</i> .HB.TD.prn<br><i>circuit-file</i> .HB.FD.prn<br><i>circuit-file</i> .hb_ic.prn | INDEX TIME<br>INDEX FREQ<br>INDEX TIME |
| .PRINT HB FORMAT=SPLOT      | <i>circuit-file</i> .HB.TD.prn<br><i>circuit-file</i> .HB.FD.prn<br><i>circuit-file</i> .hb_ic.prn | INDEX TIME<br>INDEX FREQ<br>INDEX TIME |
| .PRINT HB FORMAT=NOINDEX    | <i>circuit-file</i> .HB.TD.prn<br><i>circuit-file</i> .HB.FD.prn<br><i>circuit-file</i> .hb_ic.prn | TIME<br>FREQ<br>TIME                   |
| .PRINT HB FORMAT=CSV        | circuit-file.HB.TD.csv<br>circuit-file.HB.FD.csv<br>circuit-file.hb_ic.csv                         | TIME<br>FREQ<br>TIME                   |
| .PRINT HB FORMAT=TECPLOT    | <i>circuit-file</i> .HB.TD.dat<br><i>circuit-file</i> .HB.FD.dat<br><i>circuit-file</i> .hb_ic.dat | TIME<br>FREQ<br>TIME                   |
| .PRINT HB_FD                | circuit-file.HB.FD.prn   | INDEX FREQ                             |
| .PRINT HB_FD FORMAT=GNUPLOT | circuit-file.HB.FD.prn   | INDEX FREQ                             |
| .PRINT HB_FD FORMAT=SPLOT   | circuit-file.HB.FD.prn   | INDEX FREQ                             |
| .PRINT HB_FD FORMAT=NOINDEX | circuit-file.HB.FD.prn   | FREQ                                   |
| .PRINT HB_FD FORMAT=CSV     | circuit-file.HB.FD.csv   | FREQ                                   |
| .PRINT HB_FD FORMAT=TECPLOT | circuit-file.HB.FD.dat   | FREQ                                   |
| .PRINT HB_TD                | circuit-file.HB.TD.prn   | INDEX TIME                             |
| .PRINT HB_TD FORMAT=GNUPLOT | circuit-file.HB.TD.prn   | INDEX TIME                             |
| .PRINT HB_TD FORMAT=SPLOT   | circuit-file.HB.TD.prn   | INDEX TIME                             |
|                             |  |  |

Table 2-20. Print HB Analysis Type

|  | o. I filit fib Allalysis Type |                      |
|--|-------------------------------|----------------------|
| Trigger  | Files                         | Columns/Description  |
| .PRINT HB_TD FORMAT=NOINDEX  | circuit-file.HB.TD.prn        | TIME                 |
| .PRINT HB_TD FORMAT=CSV  | circuit-file.HB.TD.csv        | TIME                 |
| .PRINT HB_TD FORMAT=TECPLOT  | circuit-file.HB.TD.dat        | TIME                 |
|  | Startup Period                |                      |
| .OPTIONS HBINT STARTUPPERIODS= <n> .PRINT HB_STARTUP</n>   | circuit-file.startup.prn      | INDEX TIME           |
| .OPTIONS HBINT STARTUPPERIODS= <n> .PRINT HB_STARTUP FORMAT=GNUPLOT</n>  | circuit-file.startup.prn      | INDEX TIME           |
| .OPTIONS HBINT STARTUPPERIODS= <n> .PRINT HB_STARTUP FORMAT=SPLOT</n>  | circuit-file.startup.prn      | INDEX TIME           |
| .OPTIONS HBINT STARTUPPERIODS= <n> .PRINT HB_STARTUP FORMAT=NOINDEX</n>  | circuit-file.startup.prn      | TIME                 |
| .OPTIONS HBINT STARTUPPERIODS= <n> .PRINT HB_STARTUP FORMAT=CSV .OPTIONS HBINT STARTUPPERIODS=<n></n></n>  | circuit-file.startup.csv      | TIME                 |
| .OPTIONS HBINT STARTUPPERIODS= <n> .PRINT HB_STARTUP FORMAT=TECPLOT .OPTIONS HBINT STARTUPPERIODS=<n></n></n>  | circuit-file.startup.dat      | TIME                 |
| To the state of th | nitial Conditions             |                      |
| .OPTIONS HBINT SAVEICDATA=1 .PRINT HB_IC   | circuit-file.hb_ic.prn        | INDEX TIME           |
| .OPTIONS HBINT SAVEICDATA=1 .PRINT HB_IC FORMAT=GNUPLOT  | circuit-file.hb_ic.prn        | INDEX TIME           |
| .OPTIONS HBINT SAVEICDATA=1 .PRINT HB_IC FORMAT=SPLOT  | circuit-file.hb_ic.prn        | INDEX TIME           |
| .OPTIONS HBINT SAVEICDATA=1 .PRINT HB_IC FORMAT=NOINDEX  | circuit-file.hb_ic.prn        | TIME                 |
| .OPTIONS HBINT SAVEICDATA=1 .PRINT HB_IC FORMAT=CSV  | circuit-file.hb_ic.csv        | TIME                 |
| .OPTIONS HBINT SAVEICDATA=1 .PRINT HB_IC FORMAT=TECPLOT  | circuit-file.hb_ic.dat        | TIME                 |
| Additional Output Available  |                               |                      |
| .OP  | log file                      | Operating point data |
| .SENS<br>.PRINT SENS   | see Print Sensitivity         |                      |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY</method>  | see Pr                        | rint Homotopy        |

## 2.1.31.4. Print Noise Analysis

NOISE Analysis generates two output files, the primary output is in the frequency domain and the initial conditions output is in the time domain.

Table 2-21. Print NOISE Analysis Type

|                                 | 2 2:                        |                      |
|---------------------------------|-----------------------------|----------------------|
| Trigger                         | Files                       | Columns/Description  |
| .PRINT NOISE                    | circuit-file.NOISE.prn      | INDEX FREQ           |
| .PRINT NOISE FORMAT=GNUPLOT     | circuit-file.NOISE.prn      | INDEX FREQ           |
| .PRINT NOISE FORMAT=SPLOT       | circuit-file.NOISE.prn      | INDEX FREQ           |
| .PRINT NOISE FORMAT=NOINDEX     | circuit-file.NOISE.prn      | FREQ                 |
| .PRINT NOISE FORMAT=CSV         | circuit-file.NOISE.csv      | FREQ                 |
| .PRINT NOISE FORMAT=TECPLOT     | circuit-file.NOISE.dat      | FREQ                 |
|                                 | Additional Output Available |                      |
| .OP                             | log file                    | Operating point data |
| .OPTIONS NONLIN                 |                             |                      |
| CONTINUATION= <method></method> | see Print Homotopy          |                      |
| .PRINT HOMOTOPY                 |                             |                      |

# 2.1.31.5. Print Transient Analysis

Transient Analysis generates time domain output based on the format specified by the .PRINT command.

Homotopy and sensitivty output can also be generated.

**Table 2-22. Print Transient Analysis Type** 

| Trigger                           | Files                    | Columns/Description           |  |
|-----------------------------------|--------------------------|-------------------------------|--|
| .PRINT TRAN                       | <i>circuit-file</i> .prn | INDEX TIME                    |  |
| .PRINT TRAN FORMAT=GNUPLOT        | <i>circuit-file</i> .prn | INDEX TIME                    |  |
| .PRINT TRAN FORMAT=SPLOT          | <i>circuit-file</i> .prn | INDEX TIME                    |  |
| .PRINT TRAN FORMAT=NOINDEX        | <i>circuit-file</i> .prn | TIME                          |  |
| .PRINT TRAN FORMAT=CSV            | circuit-file.csv         | TIME                          |  |
| .PRINT TRAN FORMAT=RAW            | <i>circuit-file.</i> raw | TIME                          |  |
| Xyce -a<br>.PRINT TRAN FORMAT=RAW | circuit-file.raw         | TIME                          |  |
| .PRINT TRAN FORMAT=TECPLOT        | <i>circuit-file</i> .dat | TIME                          |  |
| .PRINT TRAN FORMAT=PROBE          | <i>circuit-file</i> .csd | <del>-</del>                  |  |
| Command Line Raw Override Output  |                          |                               |  |
| Xyce -r raw-file-name             | raw-file-name            | All circuit variables printed |  |

**Table 2-22. Print Transient Analysis Type** 

| Trigger   | Files                       | Columns/Description           |
|---|-----------------------------|-------------------------------|
| Xyce -r raw-file-name -a  | raw-file-name               | All circuit variables printed |
|   | Additional Output Available |                               |
| .OP   | log file                    | Operating point data          |
| .SENS<br>.PRINT SENS  | see                         | Print Sensitivity             |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY</method> | see                         | Print Homotopy                |

## 2.1.31.6. Print Homotopy

Homotopy output is generated by the inclusion of the

.OPTIONS NONLIN CONTINUATION = < method > command.

Table 2-23. Print Homotopy

| Trigger  | Files                     | Columns/Description |
|--|---------------------------|---------------------|
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY</method>                | circuit-file.HOMOTOPY.prn | INDEX TIME          |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY FORMAT=GNUPLOT</method> | circuit-file.HOMOTOPY.prn | INDEX TIME          |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY FORMAT=SPLOT</method>   | circuit-file.HOMOTOPY.prn | INDEX TIME          |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY FORMAT=NOINDEX</method> | circuit-file.HOMOTOPY.prn | TIME                |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY FORMAT=CSV</method>     | circuit-file.HOMOTOPY.csv | TIME                |
| .OPTIONS NONLIN CONTINUATION= <method> .PRINT HOMOTOPY FORMAT=TECPLOT</method> | circuit-file.HOMOTOPY.dat | TIME                |

## 2.1.31.7. Print Sensitivity

Sensitivity is enabled by inclusion of the .SENS command.

Steady-state sensitivities (adjoint or direct) and transient direct sensitivities will be handled by the .PRINT SENS command. Transient adjoint, on the other hand, is handled by the .PRINT TRANADJOINT

#### command.

For transient sensitivity output, a TIME column will be included for the STD, GNUPLOT, SPLOT, NOINDEX and CSV formats. For AC sensitivity output, a FREQ column will be included for the STD, GNUPLOT, SPLOT, NOINDEX and CSV formats.

Table 2-24. Print Sensitivities for .TRAN and .DC

| Trigger  | Files                 | Columns/Description  |
|--|-----------------------|--|
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ 1][, $p_n$ ] $\star$ .PRINT SENS                | circuit-file.SENS.prn | $obj \operatorname{d}\!obj/\operatorname{d}(p_1) \operatorname{d}\!obj/\operatorname{d}(p_n)$    |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=GNUPLOT | circuit-file.SENS.prn | $obj \operatorname{d}\!obj/\operatorname{d}(p_1) \operatorname{d}\!obj/\operatorname{d}(p_n)$    |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ 1][, $p_n$ ] $\star$ .PRINT SENS FORMAT=SPLOT   | circuit-file.SENS.prn | $obj \operatorname{d}\!obj/\operatorname{d}(p_1)\operatorname{d}\!obj/\operatorname{d}(p_n)$     |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=NOINDEX | circuit-file.SENS.prn | $obj  \mathrm{d}obj/\mathrm{d}(p_1)  \mathrm{d}obj/\mathrm{d}(p_n)$                              |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ 1][, $p_n$ ] * .PRINT SENS FORMAT=CSV           | circuit-file.SENS.csv | $obj \operatorname{d}\!obj/\operatorname{d}\!(p_1)\operatorname{d}\!obj/\operatorname{d}\!(p_n)$ |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=TECPLOT  | circuit-file.SENS.dat | $obj  dobj/d(p_1)  dobj/d(p_n)$  |

Table 2-25. Print Sensitivities for .AC

| Trigger  | Files                    | Columns/Description               |
|--|--------------------------|-----------------------------------|
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT SENS                | circuit-file.FD.SENS.prn | $obj dobj/d(p_1) dobj/d(p_n)$     |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=GNUPLOT | circuit-file.FD.SENS.prn | $obj dobj/d(p_1) dobj/d(p_n)$     |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=SPLOT   | circuit-file.FD.SENS.prn | $obj dobj/d(p_1) dobj/d(p_n)$     |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=NOINDEX | circuit-file.FD.SENS.prn | $obj dobj/d(p_1) dobj/d(p_n)$     |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_11$ ][, $p_n$ ]* .PRINT SENS FORMAT=CSV            | circuit-file.FD.SENS.csv | $obj \ dobj/d(p_1) \ dobj/d(p_n)$ |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ ][, $p_n$ ] $\star$ .PRINT SENS FORMAT=TECPLOT  | circuit-file.FD.SENS.dat | $obj dobj/d(p_1) dobj/d(p_n)$     |

**Table 2-26. Print Transient Adjoint Sensitivities** 

| Trigger   | Files                  | Columns/Description           |
|---|------------------------|-------------------------------|
| .SENS objfunc= $<\!obj>$ p= $[p_11][,p_n]\star$ .PRINT TRANADJOINT                                    | circuit-file.TRADJ.prn | $obj dobj/d(p_1) dobj/d(p_n)$ |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ 1][, $p_n$ ] $\star$ .PRINT TRANADJOINT FORMAT=NOINDEX | circuit-file.TRADJ.prn | $obj dobj/d(p_1) dobj/d(p_n)$ |

Table 2-26. Print Transient Adjoint Sensitivities

| Trigger  | Files                  | Columns/Description               |
|--|------------------------|-----------------------------------|
| .SENS objfunc= $<\!obj>$ p=[ $p_11$ ][, $p_n$ ] $\star$ .PRINT TRANADJOINT FORMAT=CSV                | circuit-file.TRADJ.csv | $obj dobj/d(p_1) dobj/d(p_n)$     |
| .SENS objfunc= $\langle obj \rangle$ p=[ $p_1$ ][, $p_n$ ] $\star$ .PRINT TRANADJOINT FORMAT=TECPLOT | circuit-file.TRADJ.dat | $obj \ dobj/d(p_1) \ dobj/d(p_n)$ |

### 2.1.31.8. Print Embedded Sampling Analysis

EMBEDDEDSAMPLING Analysis generates one output file, with the information for each output variable grouped in a set of contiguous columns, based on the format specified by the .PRINT command. The arguments OUTPUT\_SAMPLE\_STATS and OUTPUT\_ALL\_SAMPLES are specific to .PRINT ES lines. Section 2.1.5 has more details on their usage.

For a transient analysis, a TIME column will also be included for the STD, GNUPLOT, SPLOT, NOINDEX and CSV formats. The TIME variable will also be included in the TECPLOT format for that case.

Table 2-27. Print EMBEDDEDSAMPLING Analysis Type

| Trigger                  | Files               | Columns/Description |
|--------------------------|---------------------|---------------------|
| .PRINT ES                | circuit-file.ES.prn | INDEX               |
| .PRINT ES FORMAT=GNUPLOT | circuit-file.ES.prn | INDEX               |
| .PRINT ES FORMAT=SPLOT   | circuit-file.ES.prn | INDEX               |
| .PRINT ES FORMAT=NOINDEX | circuit-file.ES.prn | -                   |
| .PRINT ES FORMAT=CSV     | circuit-file.ES.csv | _                   |
| .PRINT ES FORMAT=TECPLOT | circuit-file.ES.dat | -                   |

#### 2.1.31.9. Print Intrusive PCE Analysis

PCE Analysis generates one output file, with the information for each output variable grouped in a set of contiguous columns, based on the format specified by the <code>.PRINT</code> command. The arguments <code>OUTPUT\_SAMPLE\_STATS</code> and <code>OUTPUT\_ALL\_SAMPLES</code> are specific to <code>.PRINT PCE</code> lines. Section 2.1.27 has more details on their usage.

For a transient analysis, a TIME column will also be included for the STD, GNUPLOT, SPLOT, NOINDEX and CSV formats. The TIME variable will also be included in the TECPLOT format for that case.

Table 2-28. Print PCE Analysis Type

| Trigger                   | Files                | Columns/Description |
|---------------------------|----------------------|---------------------|
| .PRINT PCE                | circuit-file.PCE.prn | INDEX               |
| .PRINT PCE FORMAT=GNUPLOT | circuit-file.PCE.prn | INDEX               |

Table 2-28. Print PCE Analysis Type

| Trigger                   | Files                | Columns/Description |
|---------------------------|----------------------|---------------------|
| .PRINT PCE FORMAT=SPLOT   | circuit-file.PCE.prn | INDEX               |
| .PRINT PCE FORMAT=NOINDEX | circuit-file.PCE.prn | -                   |
| .PRINT PCE FORMAT=CSV     | circuit-file.PCE.csv | -                   |
| .PRINT PCE FORMAT=TECPLOT | circuit-file.PCE.dat | -                   |

## 2.1.31.10. Parameter Stepping

During parameter stepping, enabled with the .STEP command, the output generated by each of analysis types varies. Generally the FORMAT indicates this variation, however some combinations of analysis and format can result in additional variation.

The following table lists how the output differs for each analysis type and format.

| Print Type | Format        | Description             |
|------------|---------------|-------------------------|
| AC         | STD           | 1, 3, 4, 11, 12, 13     |
| AC         | GNUPLOT       | 1, 3, 4, 11, 12, 13, 20 |
| AC         | SPLOT         | 1, 3, 4, 11, 12, 13, 21 |
| AC         | CSV           | 4, 11                   |
| AC         | PROBE         | 16                      |
| AC         | TECPLOT       | 4, 12, 13, 18           |
| AC         | RAW           | 19                      |
| AC         | RAW (Xyce -a) | 19                      |
| AC_IC      | STD           | 1, 4, 11, 12, 13        |
| AC_IC      | GNUPLOT       | 1, 4, 11, 12, 13, 20    |
| AC_IC      | SPLOT         | 1, 4, 11, 12, 13, 21    |
| AC_IC      | CSV           | 4, 11                   |
| AC_IC      | PROBE         | 16                      |
| AC_IC      | TECPLOT       | 12, 13, 18              |
| AC_IC      | RAW           | 19                      |
| AC_IC      | RAW (Xyce -a) | 19                      |
| DC         | STD           | 1, 11, 12               |
| DC         | GNUPLOT       | 1, 11, 12, 20           |
| DC         | SPLOT         | 1, 11, 12, 21           |
| DC         | CSV           | 11                      |
| DC         | PROBE         | 17                      |
| DC         | TECPLOT       | 4, 12, 13, 18           |
| DC         | RAW           | 19                      |
| DC         | RAW (Xyce -a) | 19                      |

| Print Type  | Format            | Description             |
|-------------|-------------------|-------------------------|
| HB_TD       | STD               | 1, 2, 4, 11, 12, 13     |
| HB_TD       | GNUPLOT           | 1, 2, 4, 11, 12, 13, 20 |
| HB_TD       | SPLOT             | 1, 2, 4, 11, 12, 13, 21 |
| HB_TD       | CSV               | 11                      |
| HB_TD       | TECPLOT           | 12, 13, 18              |
| HB_FD       | STD               | 1, 3, 4, 11, 12, 13     |
| HB_FD       | GNUPLOT           | 1, 3, 4, 11, 12, 13, 20 |
| HB_FD       | SPLOT             | 1, 3, 4, 11, 12, 13, 21 |
| HB_FD       | CSV               | 4, 11                   |
| HB_FD       | TECPLOT           | 4, 12, 13, 18           |
| HB_IC       | STD               | 1, 2, 4, 11, 12, 13     |
| HB_IC       | GNUPLOT           | 1, 2, 4, 11, 12, 13, 20 |
| HB_IC       | SPLOT             | 1, 2, 4, 11, 12, 13, 21 |
| HB_IC       | CSV               | 11                      |
| HB_IC       | TECPLOT           | 12, 13, 18              |
| HB_STARTUP  | STD               | 1, 2, 4, 11, 12, 13     |
| HB_STARTUP  | GNUPLOT           | 1, 2, 4, 11, 12, 13, 20 |
| HB_STARTUP  | SPLOT             | 1, 2, 4, 11, 12, 13, 21 |
| HB_STARTUP  | CSV               | 11                      |
| HB_STARTUP  | TECPLOT           | 12, 13, 18              |
| TRAN        | STD               | 1, 2, 11, 12            |
| TRAN        | GNUPLOT           | 1, 2, 11, 12, 20        |
| TRAN        | SPLOT             | 1, 2, 11, 12, 21        |
| TRAN        | CSV               | 2, 11                   |
| TRAN        | PROBE             | 17                      |
| TRAN        | TECPLOT           | 2, 4, 12, 13, 18        |
| TRAN        | RAW               | 2, 19                   |
| TRAN        | RAW (Xyce -a)     | 2, 19                   |
|             | Specialized Outpu | ut Commands             |
| НОМОТОРУ    | STD               | 1, 2, 4, 11, 15         |
| НОМОТОРУ    | GNUPLOT           | 1, 2, 4, 11, 15, 20     |
| НОМОТОРУ    | SPLOT             | 1, 2, 4, 11, 15, 21     |
| НОМОТОРУ    | CSV               | 2, 11                   |
| НОМОТОРУ    | PROBE             | 17                      |
| НОМОТОРУ    | TECPLOT           | 2, 4, 15, 18            |
| SENSITIVITY | STD               | 1, 2, 11, 14            |
| SENSITIVITY | GNUPLOT           | 1, 2, 11, 14, 20        |

| Print Type  | Format  | Description      |
|-------------|---------|------------------|
| SENSITIVITY | SPLOT   | 1, 2, 11, 14, 21 |
| SENSITIVITY | CSV     | 2, 11            |
| SENSITIVITY | TECPLOT | 2, 14, 18        |

| Description |  |
|-------------|--|
| 1           | INDEX column added to output variable list   |
| 2           | TIME column added to output variable list  |
| 3           | FREQ column added to output variable list  |
| 4           | Frequency domain data written as $\operatorname{Re}\left(var\right)$ and $\operatorname{Im}\left(var\right)$ |
| 11          | INDEX resets to zero at start of each .STEP  |
| 12          | Prints 'End of Xyce(TM) Parameter Sweep' at end of .STEP simulation  |
| 13          | Prints 'End of Xyce(TM) Simulation' at end of nonSTEP simulation   |
| 14          | Prints 'End of Xyce(TM) Sensitivity Simulation' at end of simulation   |
| 15          | Prints 'End of Xyce(TM) Homotopy Simulation' at end of simulation  |
| 16          | Two $'\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$   |
| 17          | One '#;' at end of each .STEP  |
| 18          | New ZONE for each .STEP, and AUXDATA for each .STEP parameter  |
| 19          | Prints 'Plotname: Step Analysis: Step $s$ of $n$ params' at the start of each .STEP                          |
| 20          | Inserts two blank lines before the data for steps 1,2,3, where the first step is step 0                      |
| 21          | Inserts one blank line before the data for steps $1,2,3,\ldots$ where the first step is step 0               |

#### 2.1.31.11. Print Wildcards

Wildcards are supported on .PRINT lines, as described below. In particular,  $V(\star)$  will print all of the node voltages in the circuit for all analysis modes. The  $P(\star)$  and  $W(\star)$  wildcards are supported for analysis modes (TRAN and DC) that support power calculations.

For TRAN and DC analysis modes,  $\mathbb{I}$  (\*) will print all of the currents. This includes both solution variables, which generally means those associated with voltage sources and inductors that are not coupled through a mutual inductance device, and the lead currents associated with most other devices. For TRAN and DC, the  $\mathbb{I}$  (\*) wildcard also supports lead currents for the multi-terminal J, M and Z devices via  $\mathbb{IB}$  (\*),  $\mathbb{ID}$  (\*),  $\mathbb{IG}$  (\*) and  $\mathbb{IS}$  (\*), and for the multi-terminal Q device via  $\mathbb{IB}$  (\*),  $\mathbb{IC}$  (\*),  $\mathbb{IE}$  (\*) and

IS (\*). The IE (\*) wildcard is also supported for SOI devices. A request for I (\*) will not return any of the lead currents for J, M, Q or Z devices. Wildcards of the form I1 (\*), that use numerical designators, are only supported for the T and YGENEXT devices. Finally, as an example, a request for IC(\*) in a netlist that does not contain any Q devices will be silently ignored.

For AC and NOISE analysis modes, the  $\mathbb{I}$  (\*) operator will only output the branch currents, since lead currents are not supported for those two analysis modes. The VR (\*), VI (\*), VP (\*), VM (\*), VDB (\*), IR (\*), II (\*), IP (\*), IM (\*) and IDB (\*) wildcards are also supported for these two analysis modes

There is also support for the \* character (meaning "zero or more characters") and the ? character (meaning "any one character") in more complex wildcards, where the \* and/or ? characters can be in any positions in the wildcard specification. For example, V(X1\*) will output the voltage at all nodes in subcircuit X1 for all analysis modes. As another example, V(1?) will output the voltage at all nodes that have two-character names that start with the character 1. These more complex wildcards should work for all supported voltage operators.

Similarly, P(X1\*) or W(X1\*) will output the power for all devices, that support power calculations, in subcircuit X1. Devices that don't support power calculations will be silently omitted. Alternately, P(R?) or W(R?) will output the power for all resistors that have two-character names.

More complex wildcards are also supported for all valid current operators. The caveats are that for DC and TRAN analyses, the wildcard will include both branch and lead currents. For AC and NOISE analyses, the wildcard will only include branch currents.

#### 2.1.31.12. Device Parameters and Internal Variables

This subsection describes how to print out device parameters and device internal variables, via a simple V-R circuit example. In particular, the example given below gives illustrative examples of how to print out the voltage at a node (V(1)), the current through a device (I(V1)), the current through a device using using an internal solution variable (N(V1\_branch)), a device parameter (R1:R) and the power dissipated by a device (P(R1)). It also shows how device parameters and internal variables can be used in a Xyce expression.

```
* filename is example.cir
.DC V1 1 2 1
V1 1 0 1
R1 1 0 2
.PRINT DC FORMAT=NOINDEX PRECISION=2 WIDTH=8
+ V(1) I(V1) N(V1_branch) R1:R P(R1) {R1:R*N(V1_branch)*I(V1)}
.END
```

The Xyce output would then be (where the NOFORMAT, WIDTH and PRECISION arguments were used mainly to format the example output for this guide):

```
V(1)
           I(V1)
                 N(V1_BRANCH)
                                   R1:R
                                               P(R1)
                                                        {R1:R*N(V1 BRANCH)*I(V
1.00e+00
          -5.00e-01
                      -5.00e-01
                                  2.00e+00
                                              5.00e-01
                                                          5.00e-01
2.00e+00
          -1.00e+00
                      -1.00e+00
                                  2.00e+00
                                              2.00e+00
                                                          2.00e+00
```

The internal solution variables for each Xyce device are typically not given in the Reference Guide sections on those devices. However, if for the example given above, the user runs Xyce <code>-namesfile</code> <code>example\_names</code> <code>example.cir</code> then the file <code>example\_names</code> would contain a list of the two solution variables that are accessible with the N() syntax on a <code>.PRINT</code> line. In this simple example, they are the voltage at Node 1 and the branch current through the voltage source V1. If V1 was in a subcircuit then the <code>example\_names</code> file would have shown the "fully-qualified" device name, including the subcircuit names.

```
HEADER
0 v1_branch
1 1
```

Additional (and more useful) examples for using the N() syntax to print out:

- The M, R, B and H internal variables for mutual inductors are given in Section 2.3.6. This includes an example where the mutual inductor is in a sub-circuit.
- The  $g_m$  (tranconductance),  $V_{th}$ ,  $V_{ds}$ ,  $V_{gs}$ ,  $V_{bs}$ , and  $V_{dsat}$  internal variables for the BSIM3 and BSIM4 models for the MOSFET are given in Section 2.3.20.

In these two cases, only the M and R variables for the mutual inductors are actually solution variables. However, the -namesfile approach can still be used to determine the fully-qualified Xyce device names required to use the N () syntax.

# 2.1.32. RESULT (Print results)

Outputs the value of user-specified expressions at the end of a simulation.

### Comments

RESULT {V(a)}
RESULT {V(a)}
RESULT {V(a) + V(b)}

Comments

The .RESULT line must use an expression. The line .RESULT V(a) will result in a parse error.

Each .RESULT line must have only one expression. Multiple .RESULT lines can be used though to output multiple columns in the output .res file.

Xyce will not produce output for .RESULT statements if there are no .STEP statements in the netlist.

## 2.1.32.1. Example Netlist

.RESULT lines can be combined with .STEP lines to output the ending values of multiple simulation runs in one .res file, as shown in the following usage example. The resultant .res file will have four lines that give the final values of the expressions  $\{v(b)\}$  and  $\{v(b)*v(b)/2\}$  at time=0.75 seconds for all four requested combinations of R2 and v\_amplitude.

```
Simple Example of .RESULT capability with .STEP R1 a b 10.0 R2 b 0 2.0

.GLOBAL_PARAM v_amplitude=2.0 Va a 0 sin (5.0 {v_amplitude} 1.0 0.0 0.0)

.PRINT TRAN v(b) {v(b)*v(b)/2}

.TRAN 0 0.75

.STEP R2 1.0 2.0 1.0

.STEP v_amplitude 1.0 2.0 1.0

.RESULT {v(b)}

.RESULT {v(b)*v(b)/2}
```

# 2.1.33. . SAMPLING (Sampling UQ Analysis)

.SAMPLING

Calculates a full analysis (.DC, .TRAN, .AC, etc.) over a distribution of parameter values. Sampling operates similarly to .STEP, except that the parameter values are generated from random distributions rather than sweeps. If used in conjunction with projection-based PCE methods, then the sample points are not based on random samples. Instead they are based on the quadrature points.

```
+ param=<parameter name>, [parameter name] *
              + type=<parameter type>, [parameter type] *
              + means=<mean>, [mean] *
              + std_deviations=<standard deviation>, [standard
              deviation] *
Examples
              .SAMPLING
              + param=R1
              + type=normal
              + means=3K
              + std_deviations=1K
              .SAMPLING
              + param=R1,R2
              + type=uniform, uniform
              + lower_bounds=1K,2K
              + upper_bounds=5K,6K
              .SAMPLING
              + useExpr=true
              .options SAMPLES numsamples=10000
              .options SAMPLES numsamples=25000
              + OUTPUTS={R1:R}, {V(1)}
              + SAMPLE TYPE=MC
              .options SAMPLES numsamples=1000
              + MEASURES=maxSine
              + SAMPLE_TYPE=LHS
              .options samples numsamples=30
              + covmatrix=1e6,1.0e-3,1.0e-3,4e-14
              + OUTPUTS={V(1)}, {R1:R}, {C1:C}
```

# **Arguments and Options**

**General Form** 

param

Names of the parameters to be sampled. This may be any of the parameters that are valid for .STEP, including device instance, device model, or global

parameters. If more than one parameter, then specify as a comma-separated list.

## type

Distribution type for each parameter. This may be uniform or normal. If more than one parameter, then specify as a comma-separated list.

#### means

If using normal distributions, the mean for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

## std\_deviations

If using normal distributions, the standard deviation for each parameter must be specified. If more than one parameter, then specify as a comma-separated list.

### lower bounds

If using uniform distributions, the lower bound must be specified. This is optional for normal distributions. If used with normal distributions, may alter the mean and standard deviation. If more than one parameter, then specify as a comma-separated list.

## upper\_bounds

If using uniform distributions, the upper bound must be specified. This is optional for normal distributions. If used with normal distributions, may alter the mean and standard deviation. If more than one parameter, then specify as a comma-separated list.

### useExpr

If this argument is set to true, then the sampling algorithm will set up random inputs from expression operators such as AGAUSS and AUNIF. In this case it will also ignore the list of parameters on the .SAMPLING command line. For a complete description of expression-based random operators, see the expression documentation in section 2.2.

## **Comments**

In addition to the .SAMPLING command, this analysis requires a .options SAMPLES command as well. The .SAMPLING command specifies parameters and their attributes, either using the useExpr option, or with comma-separated lists. The .options SAMPLES command specifies analysis options, including the number of samples, the type of sampling (LHS or MC) and the outputs and/or measures for which to compute statistics. This line also allows one to specify a non-intrusive Polynomial Chaos Expansion (PCE) method (either regression or projection PCE). To see the details of the .options SAMPLES command, see table 2-9.

On the .SAMPLING command line, if not using useExpr, parameters and their attributes must be specified using comma-separated lists. The comma-separated lists must all be the same length.

# 2.1.34. . SAVE (Save operating point conditions)

Stores the operating point of a circuit in the specified file for use in subsequent simulations. The data may be saved as .IC or .NODESET lines.

## **General Form**

.SAVE [TYPE=<IC|NODESET>] [FILE=<filename>] [LEVEL=<all|none>]

+ [TIME=<save\_time>]

## **Examples**

.SAVE TYPE=IC FILE=mycircuit.ic

.SAVE TYPE=NODESET FILE=myothercircuit.ic

.include mycircuit.ic

## **Comments**

The file created by .SAVE will contain .IC or .NODESET lines containing all the voltage node values at the DC operating point of the circuit. The default **TYPE** is NODESET. The default filename is netlist.cir.ic.

The resulting file may be used in subsequent simulations to obtain quick DC convergence simply by including it in the netlist, as in the third example line above. Xyce has no corresponding . LOAD statement.

The **LEVEL** parameter is included for compatibility with HSPICE netlists. If none is specified, then no save file is created. The default **LEVEL** is all.

**TIME** is also an HSPICE compatibility parameter. This is unsupported in Xyce. Xyce outputs the save file only at time=0.0.

## 2.1.35. . SENS (Compute DC, AC or transient sensitivities)

Computes sensitivies for a user-specificed objective function with respect to a user-specified list of circuit parameters.

#### **General Form**

.SENS objfunc=<output expression(s)> param=<circuit
parameter(s)>

## **Examples**

```
.SENS objfunc=\{0.5*(V(B)-3.0)**2.0\} param=R1:R,R2:R
.options SENSITIVITY direct=1 adjoint=1
.SENS objfunc=\{I(VM)\}, \{V(3)*V(3)\} param= Q2N2222:bf
.param RES=1k
.SENS objfunc={RES*V(3)*V(3)} param=C1:C
.param res=2
.func powerTestFunc(I) {res*I*I}
.SENS objfunc={powerTestFunc(I(V1))} param=R1:R
.global_param res=2
.SENS objfunc={res*I(V1)} param=R1:R
.global_param res=3.0k
.SENS objfunc={res*I(V1)} param=res
* AC example using objvars
.sens objvars=2,3 param=r1:r,c1:c,v1:acmag
* AC example using acobjfunc
.sens acobjfunc=\{2.0 * V(2)\}, \{I(VM)\} param=r1:r,c1:c
```

## **Comments**

This capability can be applied to either DC, transient or AC analysis. Both direct and adjoint sensitivities are supported. The user can optionally request either direct or adjoint sensitivities, or both.

Although Xyce will allow the user to specify both direct and adjoint, one would generally not choose to do both. The best choice of sensitivity method depends on the problem. For problems with a small number of parameters, and (possibly) lots of objective functions, then the direct method is a more efficient choice. For problems with large numbers of parameters, but a small number of objective functions, the adjoint method is more efficient.

For all variants of sensitivity analysis, it is necessary to specify circuit parameters on the .SENS line in a comma-separated list. Unlike the SPICE version, this capability will not automatically use every parameter in the circuit. It is also necessary for all variations of sensitivity analysis to specify at least one objective function. This

capability will not assume any particular objective function. Also, it is possible to specify multiple objective functions, in a comma-separated list.

As noted, for transient analysis, both types of sensitivities are supported. Direct sensitivities are computed at each time step during the forward calculation. Transient adjoint sensitivities, in contrast, must be computed using a reverse time integration method. The reverse time integration must be performed after the original forward calculation is complete. As such, transient adjoint sensitivity calculations can be thought of as a post-processing step. One consequence of this is that transient adjoint output must be specified using the <code>.PRINT TRANADJOINT</code> type, rather than the <code>.PRINT SENS</code> type.

If transient adjoints are specified, the default behavior for the capability is for a transient sensitivity calculation be performed for each time step, even if the forward transient simulation consists of millions of steps. For adjoint calculations, this can be problematic, as adjoint methods (noted above) are not very efficient when applied to problems with a large number of objective functions. Each time step, from the point of view of transient adjoints, is effectively a separate objective function. As such, this isn't the best use of adjoints. One can specify a list of time points for which to compute transient adjoint sensitivities. For many practical problems, the sensitivies at only one or a handful of points is needed, so this is a good way to mitigate the computational cost of adjoints. The Xyce Users' Guide [1] provides an example.

If performing a sensitivity calculation with AC analysis, there are two options for the specification of the objective function. These options are both different from the DC and TRAN method. Instead of specifying objective functions with the parameter objfunc, one should either use objvars or acobjfunc. The parameter objvars should be followed by a comma separated list of voltage nodes. The parameter acobjfunc should be followed by a comma separated list of objective functions. It is not possible to use both specifications in the same netlist.

# 2.1.36. . STEP (Step Parametric Analysis)

Calculates a full analysis (.DC, .TRAN, .AC, etc.) over a range of parameter values. This type of analysis is very similar to .DC analysis. Similar to .DC analysis, .STEP supports sweeps which are linear, decade logarithmic, octave logarithmic, a list of values, or over a multivariate data table.

## LIN Linear sweep

The sweep variable is swept linearly from the starting to the ending value.

## OCT Sweep by octaves

The sweep variable is swept logarithmically by octaves.

## DEC Sweep by decades

The sweep variable is swept logarithmically by decades.

# LIST Sweep over specified values

The sweep variable is swept over an enumerated list of values.

## DATA Sweep over table of multivariate values

The sweep variables are swept over the rows of a table.

## 2.1.36.1. Linear Sweeps

```
General Form
              .STEP [LIN] <parameter name> <initial> <final> <step>
Examples
              .STEP R1 45 50 5
              .STEP V1 20 10 -1
              .STEP LIN V1 20 10 -1
              .STEP TEMP -45 -55 -10
              .STEP C101:C 45 50 5
              .STEP DLEAK: IS 1.0e-12 1.0e-11 1.0e-12
              .global_param v1_val=10
              V1 1 0 DC {v1 val}
              .STEP v1_val 20 10 -1
              .param v2_val=10
              V2 2 0 DC {v2_val}
              .STEP v2_val 20 10 -1
              .data table
              + c1 r1
              + 1e-8 1k
              + 2e-8 0.5k
              + 3e-8 0.25k
              .enddata
              .STEP data=table
```

# **Arguments and Options**

parameter name

Name of the parameter to be swept. This may be the special parameter name TEMP (the ambient simulation temperature), a device name, device instance or model parameter name, or global parameter name as defined in a .global\_param or globally-scoped .param statement.

If a device name is given, the primary parameter for that device is taken as the parameter; in the first two examples above, the primary parameters of the devices R1 and V1 are stepped (resistance and DC voltage, respectively). The C, L and I devices are then the other devices with primary parameters, which are the capacitance, inductance and DC current, respectively.

To specify a device instance parameter other than the device's primary parameter, or if the device has no primary parameter, use the syntax <device name>:sparameter name>, as in the fourth example above.

To sweep a device model parameter, use the syntax <model name>:<parameter name>, as in the fifth example above.

initial

Initial value for the parameter.

final

Final value for the parameter.

step

Value that the parameter is incremented at each step.

## **Comments**

For linear sweeps, the LIN keyword is optional.

STEP parameter analysis will sweep a parameter from its initial value to its final value, at increments of the step size. At each step of this sweep, it will conduct a full analysis (.DC, .TRAN, .AC, etc.) of the circuit.

The specification is similar to that of a .DC sweep, except that unlike .DC, only one parameter may be swept on each .STEP line. Multiple .STEP lines may be specified, forming nested step loops. The variables will be stepped in order such that the first .STEP line that appears in the netlist will be the innermost loop, and the last .STEP line will be the outermost.

Output, as designated by a .PRINT statement, is slightly more complicated in the case of a .STEP simulation. If the user has specified a .PRINT line in the input file, Xyce will output two files. All steps of the sweep will be output to a single file as usual, but with the results of each step appearing one after another with the "Index" column starting over at zero. Additionally, a file with a ".res" suffix will be produced indicating what parameters were used for each iteration of the step loops; this file will always be in columnar text format, irrespective of any FORMAT= option specified on .PRINT lines. If .RESULT lines (see section 2.1.32) appear in the netlist, the ".res" file will also contain columns for each expression given on the .RESULT lines, and the value of the result expression will be printed for each step taken.

Note that analysis lines in Xyce do not currently support use of expressions to define their parameters (e.g., end times for .TRAN analysis, or fundamental frequencies for .HB analysis), and so it is not possible to use stepped parameters to vary how the analysis will be run at each step. If each step requires different analysis parameters, this would have to be accomplished by performing separate runs of Xyce.

If the stop value is smaller than the start value, the step value should be negative. If a positive step value is given in this case, only a single point (at the start value) will be performed, and a warning will be emitted.

# 2.1.36.2. Decade Sweeps

| General Form | .STEP DEC <sweep name="" variable=""> <start> <stop> <points></points></stop></start></sweep> |
|--------------|---|
| Examples     | .STEP DEC VIN 1 100 2<br>.STEP DEC R1 100 10000 3<br>.STEP DEC TEMP 1.0 10.0 3                |

## **Comments**

The stop value should be larger than the start value. If a stop value smaller than the start value is given, only a single point at the start value will be performed, and a warning will be emitted. The points value must be an integer.

## 2.1.36.3. Octave Sweeps

| General Form | .STEP OCT <sweep name="" variable=""> <start> <stop> <points></points></stop></start></sweep> |
|--------------|---|
| Examples     | .STEP OCT VIN 0.125 64 2  |
|              | .STEP OCT TEMP 0.125 16.0 2   |
|              | .STEP OCT R1 0.015625 512 3   |
|              |   |

### **Comments**

The stop value should be larger than the start value. If a stop value smaller than the start value is given, only a single point at the start value will be performed, and a warning will be emitted. The points value must be an integer.

## 2.1.36.4. List Sweeps

| General Form | .STEP <sweep name="" variable=""> LIST <val> <val> <val></val></val></val></sweep> |
|--------------|--|
| Examples     | .STEP VIN LIST 1.0 2.0 10. 12.0<br>.STEP TEMP LIST 8.0 21.0                        |

## 2.1.36.5. Data Sweeps

# **General Form**

.STEP DATA=<data table name>

# **Examples**

.STEP data=resistorValues

.data resistorValues

+ r1 r2

+ 8.0000e+00 4.0000e+00 + 9.0000e+00 4.0000e+00

.enddata

# 2.1.37. SUBCKT (Subcircuit)

The . SUBCKT statement begins a subcircuit definition by giving its name, the number and order of its nodes and the names and default parameters that direct its behavior. The .ENDS statement signifies the end of the subcircuit definition. See Section 2.3.33 for more information on using subcircuits with the X device.

```
General Form
               .SUBCKT <name> [node] *
               + [PARAMS: [<name>=<value>] * ]
               . . .
               .ENDS
Examples
               .SUBCKT OPAMP 10 12 111 112 13
               . . .
               .ENDS
               .SUBCKT FILTER1 INPUT OUTPUT PARAMS: CENTER=200kHz,
               + BANDWIDTH=20kHz
               . . .
               .ENDS
               .SUBCKT PLRD IN1 IN2 IN3 OUT1
               + PARAMS: MNTYMXDELY=0 IO_LEVEL=1
               . . .
               .ENDS
               .SUBCKT 74LS01 A B Y
               + PARAMS: MNTYMXDELY=0 IO LEVEL=1
               . . .
               .ENDS
```

# Arguments and Options

name

The name used to reference a subcircuit.

node

An optional list of nodes. This is not mandatory since it is feasible to define a subcircuit without any interface nodes.

## PARAMS:

Keyword that provides values to subcircuits as arguments for use as expressions in the subcircuit. Parameters defined in the PARAMS: section may be used in expressions within the body of the subcircut and will take the default values specified in the subcircuit definition unless overridden by a PARAMS: section when the subcircuit is instantiated.

## **Comments**

A subcircuit designation ends with a <code>.ENDS</code> command. The entire netlist between <code>.SUBCKT</code> and <code>.ENDS</code> is part of the definition. Each time the subcircuit is called via an X device, the entire netlist in the subcircuit definition replaces the X device.

There must be an equal number of nodes in the subcircuit call and in its definition. As soon as the subcircuit is called, the actual nodes (those in the calling statement) substitute for the argument nodes (those in the defining statement).

Node zero cannot be used in this node list, as it is the global ground node.

Subcircuit references may be nested to any level. Subcircuits definitions may also be nested; a .SUBCKT statement and its closing .ENDS may appear between another .SUBCKT/.ENDS pair. A subcircuit defined inside another subcircuit definition is local to the outer subcircuit and may not be used at higher levels of the circuit netlist.

Subcircuits should include only device instantiations and possibly these statements:

- .MODEL (model definition)
- . PARAM (parameter)
- .FUNC (function)

Models, parameters, and functions defined within a subcircuit are scoped to that definition. That is they are only accessible within the subcircuit definition in which they are included. Further, if a .MODEL, .PARAM or a .FUNC statement is included in the main circuit netlist, it is accessible from the main circuit as well as all subcircuits.

Node, device, and model names are scoped to the subcircuit in which they are defined. It is allowable to use a name in a subcircuit that has been previously used in the main circuit netlist. When the subcircuit is flattened (expanded into the main netlist), all of its names are given a prefix via the subcircuit instance name. For example, Q17 becomes X3:Q17 after expansion. After expansion, all names are unique. The single exception occurs in the use of global node names, which are not expanded.

Additional illustative examples of scoping are given in the "Working with Subcircuits and Models" section of the Xyce Users' Guide [1]. Those examples apply to models and functions also.

## 2.1.38. . TRAN (Transient Analysis)

Calculates the time-domain response of a circuit for a specified duration.

```
+ [<start time value> [<step ceiling value>]] [NOOP] [UIC]
+ [{schedule( <time>, <maximum time step>, ... )}]

Examples

.TRAN lus 100ms
.TRAN lms 100ms 0ms .lms
.TRAN 0 2.0e-3 {schedule( 0.5e-3, 0, 1.0e-3, 1.0e-6, 2.0e-3, 0 )}
```

.TRAN <initial step value> <final time value>

# Arguments and Options

General Form

```
initial step value
```

Used to calculate the initial time step (see below).

```
final time value
```

Sets the end time (duration) for the analysis.

```
start time value
```

Sets the time at which output of the simulation results is to begin. Defaults to zero.

```
step ceiling value
```

Sets a maximum time step. Defaults to ((final time value)-(start time value))/10, unless there are breakpoints (see below).

```
NOOP or UIC
```

These two options are synonyms which specify that no operating point calculation is to be performed, and that the specified initial condition (from .IC lines or capacitor "IC" parameters) should be used as the transient initial condition instead. Unspecified values are set to zero. Finally, the .IC capability can only set voltage values, not current values.

```
schedule(<time>, <maximum time step>, ...)
```

Specifies a schedule for maximum allowed time steps. The list of arguments,  $t_0$ ,  $\Delta t_0$ ,  $t_1$ ,  $\Delta t_1$ , etc. implies that a maximum time step of  $\Delta t_0$  will be used while the simulation time is greater than or equal to  $t_0$  and less than  $t_1$ . A maximum time step of  $\Delta t_1$  will be used when the simulation time is greater or equal to than  $t_1$  and less than  $t_2$ . This sequence will continue for all pairs of  $t_i$ ,  $\Delta t_i$  that are given in the {schedule()}. If  $\Delta t$  is zero or negative, then no maximum time step is enforced (other than hardware limits of the host computer).

## **Comments**

The transient analysis calculates the circuit's response over an interval of time beginning with TIME=0 and finishing at <final time value>. Use a .PRINT (print) statement to get the results of the transient analysis.

Before calculating the transient response Xyce computes a bias point for the circuit that is different from the regular bias point. This is necessary because at the start of a transient analysis, the independent sources can have different values than their DC values. Specifying NOOP on the .TRAN line causes Xyce to begin the transient analysis without performing the usual bias point calculation.

The time integration algorithms within Xyce use adaptive time-stepping methods that adjust the time-step size according to the activity in the analysis. The default ceiling for the internal time step is (<final time value>-<start time value>) /10. This default ceiling value is automatically adjusted if breakpoints are present, to ensure that there are always at least 10 time steps between breakpoints. If the user specifies a ceiling value, however, it overrides any internally generated ceiling values.

Xyce is not strictly compatible with SPICE in its use of the values on the .TRAN line. In SPICE, the first number on the .TRAN line specifies the printing interval. In Xyce, the first number is the <initial step value>, which is used in determining the initial step size. The actual initial step size is chosen to be the smallest of three quantities: the <inital step value>, the <step ceiling value>, or 1/200th of the time until the next breakpoint.

The third argument to .TRAN simply determines the earliest time for which results are to be output. Simulation of the circuit always begins at TIME=0 irrespective of the setting of <start time value>.

## 2.1.39. Miscellaneous Commands

# 2.1.39.1. \* (Comment)

A netlist comment line. Whitespace at the beginning of a line is also interpreted as a comment unless it is followed by a + symbol, in which case it treats the line as a continuation.

# 2.1.39.2. ; (In-line Comment)

Add a netlist in-line comment.

# 2.1.39.3. + (Line Continuation)

Continue the text of the previous line.

# 2.2. Expressions

Xyce supports use of mathematical expressions in several contexts:

- for the values of device instance and model parameters.
- in definition of parameters in .PARAM and .GLOBAL\_PARAM statements.
- for output on .PRINT lines.

In all contexts where expressions are allowed, it is best practice to enclose them in curly braces ({}). For netlist compatibility with other simulators, expressions may be enclosed in single quotation marks instead ('). Also, in some circumstances (such as .param and .global\_param expressions), Xyce will accept expressions that are not surrounded by either braces or single quotes. However, it is recommended that the braces be used in netlists written specifically for Xyce, as this will be the most reliable option.

The expression package in Xyce supports all standard arithmetic operators, trigonometric functions, a collection of arithmetic functions, and some functions to mimic the pulse, sine, exp, and sffm time-dependent functions in the independent current and voltage sources. These functions are listed in tables 2-32 and 2-33.

Table 2-31. Operators

| Table 2 or operators |          |                                  |
|----------------------|----------|----------------------------------|
| Class of<br>Operator | Operator | Meaning                          |
| arithmetic           | +        | addition or string concatenation |
|                      | _        | subtraction                      |
|                      | *        | multiplication                   |
|                      | /        | division                         |
|                      | **       | exponentiation                   |
|                      | %        | modulus                          |
| logical <sup>1</sup> | ~        | unary NOT                        |
|                      |          | boolean OR                       |
|                      | ^        | boolean XOR                      |
|                      | &        | boolean AND                      |
| relational           | ==       | equality                         |
|                      | !=       | non-equality                     |
|                      | >        | greater-than                     |
|                      | >=       | greater-than or equal            |
|                      | <        | less-than                        |
|                      | <=       | less-than or equal               |
| conditional          | ?:       | Ternary conditional operator     |

## **Operators**

 $<sup>^1</sup>$ Logical and relational operators are used only with the  ${\tt IF}$  () function and the ternary operator for its conditional argument.

**Special note on ternary operator** Note that the ternary operator is available for use in Xyce. This operator is the same as the ternary conditional operator in C, C++, Perl, and others. The ternary expression t?a:b is equivalent to the function IF (t,a,b) described below. However, please be aware that the ternary operator has extremely low precedence just as it has in these other languages, and if parentheses are not used to make explicit which expressions are supposed to be part of the condition or true and false values, the resolution of the expression may be surprising.

For example, the expression

```
1+a==b?1:0+1
```

is equivalent to the expression

```
IF (1+a==b, 1, 0+1)
```

because the "+" and "==" operators have higher precedence than either "?" or ":". Similarly:

```
A==B?1:0 + A==C?2:0 + A==D?3:0
```

is equivalent to

```
if(A==B,1,IF(0 + A==C,2,IF(0 + A==D,3,0)))
```

Given the way the original expression is written, it appears that the intent was that the expression be evaluated as:

```
If(A==B,1,0) + IF(A==C,2,0) + IF(A==D,3,0)
```

This is not how the expression will be evaluated. Fortunately, because of the use of "0" to the right of the colons in each case, the expression just happens to give the desired result in either interpretation, but Xyce is using the nested IF equivalent.

Finally, due to restrictions on the expression parser, it is essential that ternary operators never be written so that a bare parameter is directly to the left of a colon. This is because colons are actually legal characters in parameters — the colon represents hierarchy, so that R1: R means the R parameter of device R1, and X1: A refers to the node A of subcircuit X1. Therefore, it is necessary to put at least one character that is invalid in parameter names in between the colon and the parameter. It is sufficient to use a space.

```
{(A==B) ?C:D}; this expression will generate a syntax error {(A==B) ?C:D}; this expression is acceptable {(A==B) ?C+0:D}; this expression is acceptable {(A==B) ?(C):D}; this expression is acceptable
```

Note that if using expressions without curly braces or single quotes (something that is allowed on .param and .global\_param lines) this becomes even more restrictive because the parser eats up whitespace. In this case, the expression needs to be fixed another way, such as with parenthesis.

```
(A==B) ?C:D; this expression will generate a syntax error (A==B) ?C:D; parser eliminates whitespace, causing syntax error (A==B) ?C+0:D; this expression is acceptable (A==B) ?(C):D; this expression is acceptable
```

**Table 2-32. Arithmetic Functions** 

| Function     | Meaning                                   | Explanation   |
|--------------|---|---|
|              | Arithmetic                                | functions   |
| ABS(x)       | x   | absolute value of x   |
| CEIL(x)      |   | least integer greater or equal to variable $x$                                |
| DDT(x)       | $\frac{d}{dt}x(t)$                        | time derivative of x  |
| DDX(f(x),x)  | $\frac{\partial}{\partial x}f(x)$         | partial derivative of $f(x)$ with respect to $x$                              |
| FLOOR(x)     |   | greatest integer less than or equal to variable $x$                           |
| FMOD(x,y)    |   | returns the remainder of x/y as a real number                                 |
| IF(t,x,y)    | x if $t$ is true,                         | t is an expression using the relational operators in Table 2-31. <sup>2</sup> |
|              | y otherwise                               |   |
| INT(x)       | $\operatorname{sgn}(x)\lfloor  x \rfloor$ | integer part of the real variable x   |
| LIMIT(x,y,z) | y  if  x < y                              |   |
|              | $x 	ext{ if } y < x < z$                  | x limited to range $y$ to $z$   |
|              | z  if  x > z                              |   |
| M(x)         | x   | absolute value or magnitude of $x$  |
| MIN(x,y)     | min(x, y)                                 | minimum of $x$ and $y$  |
| MAX(x,y)     | $\max(x, y)$                              | maximum of x and y  |
| NINT(x)      |   | rounds <i>x</i> up or down, to the nearest integer                            |
| PWR(x,y)     | $x^{y}$                                   | x raised to y power   |
| POW(x,y)     | $x^{y}$                                   | x raised to y power   |
| PWRS(x,y)    | $x^y$ if $x > 0$                          |   |
|              | 0  if  x = 0                              | sign corrected x raised to y power  |
|              | $-(-x)^y \text{ if } x < 0$               |   |
| SDT(x)       | $\int x(t)dt$                             | time integral of x  |
| SGN(x)       | +1  if  x > 0                             |   |
|              | 0  if  x = 0                              | sign value of $x$   |
|              | -1 if $x < 0$                             |   |
| SIGN(x,y)    | sgn(y) x                                  | sign of $y$ times absolute value of $x$                                       |
| STP(x)       | 1 if $x > 0$                              | step function   |
|              | 0 otherwise                               |   |
| SQRT(x)      | $\sqrt{x}$                                | square root of x  |
| URAMP(x)     | x  if  x > 0                              | ramp function   |
|              | 0 otherwise                               |   |

**Table 2-32. Arithmetic Functions** 

| Function Meaning                          | Explanation   |
|---|---|
| Operators related to interpol             | lating tabular data   |
| TABLE(x,y,z,*) $f(x)$ where $f(y) = z$    | piecewise linear interpolation,<br>multiple $(y,z)$ pairs can be specified  |
| TABLE("filename")                         | filename of <i>x</i> , <i>y</i> data pairs, one pair per line, space separated, is read from disk and put into a TABLE for use as function lookup table. Synonymous with TABLEFILE. |
| FASTTABLE(x,y,z,* $f(x)$ where $f(y) = z$ | piecewise linear interpolation without breakpoints, multiple $(y,z)$ pairs can be specified   |
| FASTTABLE("filename")                     | filename of <i>x</i> , <i>y</i> data pairs, one pair per line, space separated, is read from disk and put into a FASTTABLE for use as breakpoint-free function lookup table.        |
| SPLINE(x,y,z,*) $f(x)$ where $f(y) = z$   | Akima spline interpolation, multiple $(y,z)$ pairs should be specified  |
| SPLINE("filename")                        | filename of $x, y$ data pairs, one pair per line, space separated, is read from disk and put into a SPLINE for use in an Akima spline.  |
| AKIMA(x,y,z,*) $f(x)$ where $f(y) = z$    | Akima spline interpolation [9], multiple ( <i>y</i> , <i>z</i> ) pairs should be specified (synonymous with SPLINE)   |
| AKIMA("filename")                         | filename of <i>x</i> , <i>y</i> data pairs, one pair per line, space separated, is read from disk and put into a AKIMA for use in an Akima spline.                                  |
| CUBIC(x,y,z,*) $f(x)$ where $f(y) = z$    | Cubic spline interpolation, multiple $(y,z)$ pairs should be specified  |
| CUBIC("filename")                         | filename of $x, y$ data pairs, one pair per line, space separated, is read from disk and put into a CUBIC for use in an Cubic spline.   |
| WODICKA(x,y,z,*) $f(x)$ where $f(y) = z$  | Wodicka spline interpolation [10], multiple $(y,z)$ should be specified   |

**Table 2-32. Arithmetic Functions** 

| Erro et erro          | Maning                          |  |
|-----------------------|---------------------------------|--|
| Function              | Meaning                         | Explanation  |
| WODICKA("file         | ename'')                        | filename of x, y data pairs, one pair per line, space separated, is read from disk and put into a WODICKA for use in a Wodicka spline.                 |
| BLI(x,y,z,*)          | f(x) where $f(y) = z$           | Barycentric Lagrange interpolation [11], multiple $(y,z)$ pairs should be specified  |
| BLI("filename")       |                                 | filename of $x, y$ data pairs, one pair per line, space separated, is read from disk and put into a BLI for use in Barycentric Lagrance Interpolation. |
| TABLEFILE("filename") |                                 | filename of $x, y$ data pairs, one pair per line, space separated, is read from disk and put into a TABLE for use as function lookup table.            |
|                       | Operators related to con        | mplex numbers  |
| DB (x)                |                                 | output the magnitude of $x$ in decibels  |
| IMG(x)                |                                 | imaginary part of variable x   |
| PH(x)                 |                                 | phase of variable x  |
| R(x)                  |                                 | real part of variable x  |
| RE(x)                 |                                 | real part of variable x  |
|                       | Exponential, logarithmic, and t | trigonometric functions  |
| ACOS(x)               | arccos(x)                       | result in radians  |
| ACOSH(x)              | $ \cosh^{-1}(x) $               | hyperbolic arccosine of $x$  |
| ARCTAN(x)             | arctan(x)                       | result in radians  |
| ASIN(x)               | $\arcsin(x)$                    | result in radians  |
| ASINH(x)              | $ sinh^{-1}(x) $                | hyperbolic arcsine of $x$  |
| ATAN(x)               | arctan(x)                       | result in radians  |
| ATANH(x)              | $\tanh^{-1}(x)$                 | hyperbolic arctangent of x   |
| ATAN2(x,y)            | $\arctan(x/y)$                  | result in radians  |
| COS(x)                | $\cos(x)$                       | x in radians   |
| COSH(x)               | $\cosh(x)$                      | hyperbolic cosine of x   |
| EXP(x)                | $e^x$                           | e to the x power   |
| LN(x)                 | ln(x)                           | log base e   |
| LOG(x)                | $\log(x)$                       | log base 10  |
| LOG10(x)              | $\log(x)$                       | log base 10  |

Table 2-32. Arithmetic Functions

| Function                         | Meaning                     | Explanation   |
|----------------------------------|-----------------------------|---|
| SIN(x)                           | sin(x)                      | x in radians  |
| SINH(x)                          | sinh(x)                     | hyperbolic sine of x  |
| TAN(x)                           | tan(x)                      | x in radians  |
| TANH(x)                          | tanh(x)                     | hyperbolic tangent of x   |
|                                  | Operators related to random | distributions   |
| AGAUSS( $\mu$ , $\alpha$ , $n$ ) |                             | Random number sampled from normal distribution with mean $\mu$ and standard deviation $\alpha/n$          |
|                                  |                             | A deviation $\alpha$ will be $n$ standard deviations from the mean. <sup>1</sup>                          |
| GAUSS( $\mu$ , $\alpha$ , $n$ )  |                             | Random number sampled from normal distribution with mean $\mu$ and standard deviation $(\alpha * \mu)/n$  |
|                                  |                             | A deviation $\alpha * \mu$ will be <i>n</i> standard deviations from the mean. <sup>1</sup>               |
| $AUNIF(\mu,\alpha)$              |                             | Random number sampled from uniform distribution with mean $\mu$ and standard deviation $\alpha/n$         |
|                                  |                             | The number returned will differ from the mean by at most $\alpha^{-1}$                                    |
| $\text{UNIF}(\mu, \alpha)$       |                             | Random number sampled from uniform distribution with mean $\mu$ and standard deviation $(\alpha * \mu)/n$ |
|                                  |                             | The number returned will differ from the mean by at most $\alpha * \mu^{-1}$                              |
| RAND()                           |                             | random number between 0 and 1 sampled from a uniform distribution 1                                       |

## **Arithmetic Functions**

<sup>&</sup>lt;sup>1</sup>The default behavior of the random number functions RAND, GAUSS, and AGAUSS, if there are not any UQ commands such as .SAMPLING in the netlist, is to return the mean value of the operator. If a UQ command is present, then these operators can be used to define the distribution of random inputs to the UQ analysis. However, this will only happen if the UQ analysis specifically requests it using the command .SAMPLING USEEXPR=TRUE Unless a specific random seed is specified using either the -randseed command line option, or from the netlist, the random number generator will be seeded internally. In all cases, Xyce will output text to the console indicating what seed is being used.

<sup>&</sup>lt;sup>2</sup>Use of the IF function to create an expression that has step-function-like behavior as a function of a solution variable is highly likely to produce convergence errors in simulation. IF statements that have step-like behavior with an explicit time dependence are the exception, as the code will insert breakpoints at the discontinuities. Do not use step-function or other infinite-slope transitions dependent on variables other than time. Smooth the transition so that it is more easily integrated through. See the "Analog Behavioral Modeling" chapter of the Xyce Users' Guide [1] for guidance on using the IF function with the B-source device.

**Table 2-33. SPICE Compatibility Functions** 

| Function                           | Explanation                               |
|------------------------------------|---|
| SPICE_EXP(V1,V2,TD1,TAU1,TD2,TAU2) | SPICE style transient exponential         |
|                                    | V1 = initial value                        |
|                                    | V2 = pulsed value                         |
|                                    | TD1 = rise delay time                     |
|                                    | TAU1 = rise time constant                 |
|                                    | TD2 = fall delay time                     |
|                                    | TAU2 = fall time constant                 |
| SPICE_PULSE(V1,V2,TD,TR,TF,PW,PER) | SPICE style transient pulse               |
|                                    | V1 = initial value                        |
|                                    | V2 = pulsed value                         |
|                                    | TD = delay                                |
|                                    | TR = rise time                            |
|                                    | TF = fall time                            |
|                                    | PW = pulse width                          |
|                                    | PER = period                              |
| SPICE_SFFM(V0,VA,FC,MDI,FS)        | SPICE style transient single frequency FM |
|                                    | V0 = offset                               |
|                                    | VA = amplitude                            |
|                                    | FC = carrier frequency                    |
|                                    | MDI = modulation index                    |
|                                    | FS = signal frequency                     |
| SPICE_SIN(V0,VA,FREQ,TD,THETA)     | SPICE style transient sine wave           |
|                                    | V0 = offset                               |
|                                    | VA = amplitude                            |
|                                    | FREQ = frequency (hz)                     |
|                                    | TD = delay                                |
|                                    | THETA = damping factor                    |

**Spice Compatable Functions** Information about the restrictions on expressions in specific contexts is given in the subsections that follow.

# 2.2.1. Expressions in . PARAM or . GLOBAL\_PARAM Statements

Parameters defined using .PARAM and .GLOBAL\_PARAM are mostly synonymous and subject to most of the same constraints. Both types are allowed to depend on parameters defined in .PARAM or .GLOBAL\_PARAM statements, and both may contain special variables such as TIME, FREQ, TEMP or VT. Neither type may contain any references to solution variables or lead currents.

**Example:** .PARAM SQUARES=5.0

**Example:** .PARAM SHEETRES=25

**Example:** .PARAM RESISTANCE={SQUARES\*SHEETRES}

**Example:** .PARAM dTdt=.01

**Example:** .GLOBAL\_PARAM Temperature={27+dTdt\*TIME}

Both types of parameter are subject to extra constraints if used inside of subcircuits. .PARAM parameters may be defined inside of a subcircuit, while .GLOBAL\_PARAM parameters may not. Parameters inside of subcircuits may not be swept by analysis commands such as .STEP or .SAMPLING. Only globally scoped user-defined parameters can be swept in this manner. Note, this restriction does not apply to device parameters, just user-defined parameters.

## 2.2.2. Expressions in . PRINT Lines

Expressions on .PRINT lines may contain references to parameters defined in either .PARAM or .GLOBAL\_PARAM statements, device parameters using the syntax <device name>:<parameter name>, and may also contain solution variables.

```
*example with .print expressions
.PARAM RES=50
R1 1 0 {RES}
V1 1 0 sin(0 5 100khz)
.tran 1u 1m
*Print power dissipated through resistor,
*and actual resistance used in the R1
*device
.print tran {V(1)*V(1)/RES} {R1:R}
.end
```

# 2.2.3. Limitations on Using Complex Values in Expressions

The Xyce expression library was written to work with complex quantities, and can perform complex arithmetic on any set of complex inputs to produce a complex output. However, the default behavior is to print only the real part for expressions on the print line. If the user desires both the real and imaginary part, it is necessary to use operators such as Re() and Img() as follows:

```
.PRINT AC \{RE(V(N0,N1))\}\ \{IMG(V(N0,N1))\}
```

Note that this is only necessary to obtain the specific components final result. It isn't necessary to manually specify real equivalent arithmetic expressions to do complex math, although that will work. Complex arithmetic will happen automatically within the expression. So, for example, the following will work to produce the magnitude of the product of two complex-valued voltage nodes:

```
.PRINT AC \{M(V(N1) * V(N0))\}
```

## 2.2.4. Expressions for Device Instance and Model Parameters

Expressions of constants, .PARAM and .GLOBAL\_PARAM parameters may be used for the values of any device parameters in instance and model lines.

Except in very specific devices, expressions used for device parameter values must evaluate to a time-independent constant, and must not contain dependence on solution variables such as nodal voltages or currents.

```
*example of use of expressions for device parameters
.PARAM RES=50
.GLOBAL_PARAM theSaturationCurrent=1.5e-14
R1 1 0 {RES}
V1 1 0 sin(0 5 100khz)
D1 1 0 DMODEL
.MODEL D DMODEL IS=theSaturationCurrent
.step theSaturationCurrent 1e-14 5e-14 1e-14
```

Some parameters of specific devices are exceptions to the general rule. These parameters have no restrictions and may depend on any parameters, time, or solution variables in the netlist:

- The V or I instance parameters of the  $\ensuremath{\mathsf{B}}$  source.
- The CONTROL instance parameter of the switch (S device).
- The C (capacitance) instance parameter for the capacitor.
- The Q (charge) instance parameter for the capacitor.
- The coupling coefficient instance parameter for the *LINEAR* mutual inductor (K device with no model card specified)

These specific instance parameters may be time-dependent (i.e. they may reference the TIME special variable), but may not depend on any solution variables:

- The TEMP instance parameter of all devices.
- The L (inductance) parameter of the inductor.
- The R (resistance) parameter of the resistor.
- The R, RESISTIVITY, DENSITY, HEATCAPACITY and THERMAL\_HEATCAPACITY parameters of the thermal resistor (resistor level 2).

# 2.2.5. POLY expressions

The POLY keyword is available in the E, F, G, H and B dependent sources. Based on the same keyword from SPICE2, POLY provides a compact method of specifying polynomial expressions in which the variables in the polynomial are specified followed by an ordered list of polynomial coefficients. All expressions specified with POLY are ultimately translated by Xyce into an equivalent, straightforward polynomial expression in a B source. Since a straightforward polynomial expression can be easier to read, there is no real benefit to using POLY except to support netlists imported from other SPICE-based simulators.

There are three different syntax forms for POLY, which can be a source of confusion. The E and G sources (voltage-dependent voltage or current sources) use one form, the F and H sources (current-dependent voltage or current sources) use a second form, and the B source (general nonlinear source) a third form. During input processing, any of the E, F, G or H sources that use nonlinear expressions are first converted into an equivalent B source, and then any B sources that use the POLY shorthand are further converted into standard polynomial expressions. This section describes how the compact form will be translated into the final form that is used internally.

All three formats of POLY express the same three components: a number of variables involved in the expression (N, the number in parentheses after the POLY keyword), the variables themselves, and an ordered list of coefficients for the polynomial terms. Where they differ is in how the variables are expressed.

## 2.2.5.1. Voltage-controlled sources

The E and G sources are both voltage-controlled, and so their POLY format requires specification of two nodes for each voltage on which the source depends, i.e. the positive and negative nodes from which a voltage drop is computed. There must therefore be twice as many nodes as the number of variables specified in parentheses after the POLY keyword:

```
Epoly 1 2 POLY(3) n1p n1m n2p n2m n3p n3m ...
```

In this example, the voltage between nodes 1 and 2 is determined by a polynomial whose variables are V(n1p, n1m), V(n2p, n2m), V(n3p, n3m). Not shown in this example are the polynomial coefficients, which will be described later.

## 2.2.5.2. Current-controlled sources

The F and H sources are both current-controlled, and so their POLY format requires specification of one voltage source name for each current on which the source depends. There must therefore be exactly as many nodes as the number of variables specified in parentheses after the POLY keyword:

```
Fpoly 1 2 POLY(3) V1 V2 V3 ...
```

In this example, the voltage between nodes 1 and 2 is determined by a polynomial whose variables are  $\mathbb{I}(V1)$ ,  $\mathbb{I}(V2)$ , and  $\mathbb{I}(V3)$ . Not shown in this example are the polynomial coefficients, which will be described later.

#### 2.2.5.3. B sources

Finally, the most general form of POLY is that used in the general nonlinear dependent source, the B source. In this variant, each specific variable must be named explicitly (i.e. not simply by node name or by voltage source name), because currents and voltages may be mixed as needed.

In these examples, the source between nodes 1 and 2 is determined by a polynomial whose variables are  $\mathbb{I}(V1)$ ,  $\mathbb{V}(2,3)$ , and  $\mathbb{V}(3)$ . In the first example, the polynomial value determines the voltage between nodes 1 and 2, and in the second the current.

The E, F, G and H formats are all converted internally in a first step to the B format. Thus the following pairs of sources are exactly equivalent:

```
Epoly 1 2 POLY(3) n1p n1m n2p n2m n3p n3m ...
BEpoly 1 2 V={POLY(3) V(n1p,n1m) V(n2p,n2m) V(n3p,n3m) ...
Fpoly 1 2 POLY(3) V1 V2 V3 ...
BFpoly 1 2 V={POLY(3) I(V1) I(V2) I(V3) ...
```

After conversion to the B source form, the POLY form is finally converted to a normal expression using the coefficients and variables given.

Coefficients are given in a standard order, and the polynomial is built up by terms until the list of coefficients is exhausted. The first coefficient is the constant term of the polynomial, followed by the coefficients of linear terms, then bi-linear, and so on. For example:

In this example, the constant term is 1.0, and the coefficients of the three terms linear in the input variables are 0.5. Thus, this E source is precisely equivalent to the general B source:

BEstandard 1 2 
$$V = \{1.0 + .5 * V (n1p, n1m) + .5 * V (n2p, n2m) + .5 * V (n3p, n3m)\}$$

The standard ordering for coefficients is:

$$POLY(N) X_1 ... X_N C_0 C_1 ... C_N C_{11} ... C_{1N} C_{21} ... C_{N1} ... C_{NN} C_{1^{2_1}} ... C_{1^{2_N}} ...$$

with the polynomial then being:

Value = 
$$C_0 + \sum_{i=1}^{N} C_j X_j + \sum_{i=1}^{N} \sum_{j=1}^{N} C_{ij} X_i X_j + \sum_{i=1}^{N} \sum_{j=1}^{N} C_{i^2 j} X_i^2 X_j + \dots$$

Here we have used the general form  $X_i$  for the  $i^{th}$  variable, which may be either a current or voltage variable in the general case.

It should be reiterated that the POLY format is provided primarily for support of netlists from other simulators, and that its compactness may be a disadvantage in readability of the netlist and may be more prone to usage error. Xyce users are therefore advised that use of the more straightforward expression format in the B source may be more appropriate when crafting original netlists for use in Xyce. Since Xyce

| converts POLY of POLY. | format expressions to | the simpler format into | ernally, there is no perform | nance benefit to use |
|------------------------|-----------------------|-------------------------|------------------------------|----------------------|
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## 2.3. Devices

Xyce supports many devices, with an emphasis on analog devices, including sources, subcircuits and behavioral models. This section serves as a reference for the devices supported by Xyce. Each device is described separately and includes the following information, if applicable:

- a description and an example of the correct netlist syntax.
- the matching model types and their description.
- the matching list of model parameters and associated descriptions.
- the corresponding characteristic equations for the model (as required).
- references to publications on which the model is based.

User-defined models may be implemented using the .MODEL (model definition) statement, and macromodels can be created as subcircuits using the .SUBCKT (subcircuit) statement.

Please note that the characteristic equations are provided to give a general representation of the device behavior. The actual Xyce implementation of the device may be slightly different in order to improve, for example, the robustness of the device.

Table 2-34 gives a summary of the device types and the form of their netlist formats. Each of these is described below in detail.

Table 2-34. Analog Device Quick Reference.

| <b>Device Type</b>                       | Letter | Typical Netlist Format  |
|--|--------|---|
| Nonlinear Dependent<br>Source (B Source) | В      | B <name> &lt;+ node&gt; &lt;- node&gt;<br/>+ <i or="" v="">={<expression>}</expression></i></name>  |
| Capacitor                                | С      | <pre>C<name> &lt;+ node&gt; &lt;- node&gt; [model name] <value> + [IC=<initial value="">]</initial></value></name></pre>                            |
| Diode                                    | D      | D <name> <anode node=""> <cathode node=""><br/>+ <model name=""> [area value]</model></cathode></anode></name>                                      |
| Voltage Controlled Voltage<br>Source     | E      | <pre>E<name> &lt;+ node&gt; &lt;- node&gt; &lt;+ controlling node&gt; + &lt;- controlling node&gt; <gain></gain></name></pre>                       |
| Current Controlled<br>Current Source     | F      | F <name> &lt;+ node&gt; &lt;- node&gt;<br/>+ <controlling device="" name="" v=""> <gain></gain></controlling></name>                                |
| Voltage Controlled<br>Current Source     | G      | G <name> &lt;+ node&gt; &lt;- node&gt; &lt;+ controlling node&gt; + &lt;- controlling node&gt; <transconductance></transconductance></name>         |
| Current Controlled<br>Voltage Source     | Н      | H <name> &lt;+ node&gt; &lt;- node&gt;<br/>+ <controlling device="" name="" v=""> <gain></gain></controlling></name>                                |
| Independent Current<br>Source            | I      | <pre>I<name> &lt;+ node&gt; &lt;- node&gt; [[DC] <value>] + [AC [magnitude value [phase value] ] ] + [transient specification]</value></name></pre> |
| Mutual Inductor                          | K      | <pre>K<name> <inductor 1=""> [<ind. n="">*] + <linear coupling="" model="" or=""></linear></ind.></inductor></name></pre>                           |
| Inductor                                 | L      | L <name> &lt;+ node&gt; &lt;- node&gt; [model name] <value> + [IC=<initial value="">]</initial></value></name>                                      |

Table 2-34. Analog Device Quick Reference.

|                                      | Table 2-34. Al  | laiog Device Quick Reference.  |
|--------------------------------------|-----------------|--|
| <b>Device Type</b>                   | Letter          | Typical Netlist Format   |
| JFET                                 | J               | <pre>J<name> <drain node=""> <gate node=""> <source node=""/> + <model name=""> [area value]</model></gate></drain></name></pre>   |
| MOSFET                               | М               | <pre>M<name> <drain node=""> <gate node=""> <source node=""/> + <bulk node="" substrate=""> [SOI node(s)] + <model name=""> [common model parameter]*</model></bulk></gate></drain></name></pre> |
| Lossy Transmission Line (LTRA)       | 0               | O <name> <a (+)="" node="" port=""> <a (-)="" node="" port=""><br/>+ <b (+)="" node="" port=""> <b (-)="" node="" port=""><br/>+ <model name=""></model></b></b></a></a></name>                  |
| Bipolar Junction<br>Transistor (BJT) | Q               | <pre>Q<name> <collector node=""> <base node=""/> + <emitter node=""> [substrate node] + <model name=""> [area value]</model></emitter></collector></name></pre>                                  |
| Resistor                             | R               | R <name> &lt;+ node&gt; &lt;- node&gt; [model name] <value> + [L=<length>] [W=<width>]</width></length></value></name>   |
| Voltage Controlled Switch            | S               | <pre>S<name> &lt;+ switch node&gt; &lt;- switch node&gt; + &lt;+ controlling node&gt; &lt;- controlling node&gt; + <model name=""></model></name></pre>  |
| Generic Switch                       | S               | <pre>S<name> &lt;+ switch node&gt; &lt;- switch node&gt; + <model name=""> CONTROL=\{expression\}</model></name></pre>   |
| Transmission Line                    | Т               | <pre>T<name> <a +="" node="" port=""> <a -="" node="" port=""> + <b +="" node="" port=""> <b -="" node="" port=""> + <ideal specification=""></ideal></b></b></a></a></name></pre>               |
| Digital Devices                      | U               | U <name> <type> <digital node="" power=""> + <digital ground="" node=""> [node]* <model name=""></model></digital></digital></type></name>   |
| Independent Voltage<br>Source        | V               | <pre>V<name> &lt;+ node&gt; &lt;- node&gt; [[DC] <value>] + [AC [magnitude value [phase value] ] ] + [transient specification]</value></name></pre>  |
| Port Device                          | Р               | <pre>P<name> &lt;+ node&gt; &lt;- node&gt; [[DC] <value>] + port=port number [Z0 = value] + [AC [magnitude value [phase value] ] ] + [transient specification]</value></name></pre>              |
| Subcircuit                           | X               | <pre>X<name> [node] * <subcircuit name=""> + [PARAMS:[<name>=<value>] *]</value></name></subcircuit></name></pre>  |
| Current Controlled Switch            | W               | W <name> &lt;+ switch node&gt; &lt;- switch node&gt; + <controlling device="" name="" v=""> <model name=""></model></controlling></name>   |
| Digital Devices, Y Type (deprecated) | Y <type></type> | Y <type> <name> [node]* <model name=""></model></name></type>  |
| PDE Devices                          | YPDE            | YPDE <name> [node] * <model name=""></model></name>  |
| Accelerated masses                   | YACC            | YACC <name> <acceleration> <velocity> <position? +="" [x0="&lt;initial" position="">] [v0=<initial td="" velocity?<=""></initial></position?></velocity></acceleration></name>                   |
| Linear Device                        | YLIN            | YLIN <name> &lt;+ node&gt; &lt;- node&gt; <model name=""></model></name>   |
| Memristor Device                     | YMEMRISTOR      | YMEMRISTOR <name> &lt;+ node&gt; &lt;- node&gt; <model name:<="" td=""></model></name>   |
| MESFET                               | Z               | <pre>Z<name> <drain node=""> <gate node=""> <source node=""/> + <model name=""> [area value]</model></gate></drain></name></pre>   |

Table 2-35. Features Supported by Xyce Device Models

| lable 2-35. Features Supported by Xyce Device Models |                                      |                   |       |                              |                     |  |
|--|--------------------------------------|-------------------|-------|------------------------------|---------------------|--|
| Device   | Comments                             | Branch<br>Current | Power | Analytic<br>Sensi-<br>tivity | Stationary<br>Noise |  |
| Capacitor  | Age-aware, semiconductor             | Y                 | Y     | Y                            |                     |  |
| Inductor   | Coupled mutual inductors (see below) | Y                 | Y     | Y                            |                     |  |
| Linear and Nonlinear Mutual<br>Inductor              |                                      | Y                 | Y     |                              |                     |  |
| Resistor (Level 1)                                   | Normal and Semiconductor             | Y                 | Y     | Y                            | Y                   |  |
| Resistor (Level 2)                                   | Thermal Resistor                     | Y                 | Y     |                              |                     |  |
| Diode (Level 1)                                      |                                      | Y                 | Y     | Y                            | Y                   |  |
| Diode (Level 2)                                      | Addition of PSpice enhancements      | Y                 | Y     |                              |                     |  |
| Diode (Level 200)                                    | JUNCAP200 model                      | Y                 | Y     | Y                            | Y                   |  |
| Independent Voltage Source (VSRC)                    |                                      | Y                 | Y     | Y                            |                     |  |
| Independent Current Source (ISRC)                    |                                      | Y                 | Y     | Y                            |                     |  |
| Voltage Controlled Voltage<br>Source (VCVS)          |                                      | Y                 | Y     |                              |                     |  |
| Voltage Controlled Current<br>Source (VCCS)          |                                      | Y                 | Y     |                              |                     |  |
| Current Controlled Voltage<br>Source (CCVS)          |                                      | Y                 | Y     |                              |                     |  |
| Current Controlled Current<br>Source (CCCS)          |                                      | Y                 | Y     |                              |                     |  |
| Port Device  |                                      | Y                 | Y     |                              |                     |  |
| Nonlinear Dependent Source<br>(B Source)             |                                      | Y                 | Y     |                              |                     |  |

Table 2-35. Features Supported by Xyce Device Models

| Table 2-35. Features Supported by Ayce Device Models |   |                   |       |                              |                     |  |
|--|---|-------------------|-------|------------------------------|---------------------|--|
| Device   | Comments  | Branch<br>Current | Power | Analytic<br>Sensi-<br>tivity | Stationary<br>Noise |  |
| Bipolar Junction Transistor<br>(BJT) (Level 1)       |   | Y                 | Y     | Y                            | Y                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 11)      | Vertical Bipolar Intercompany (VBIC) model, version 1.3 (3-terminal)                  | Y                 | Y     | Y                            | Y                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 12)      | Vertical Bipolar Intercompany (VBIC) model, version 1.3 (4-terminal)                  | Y                 | Y     | Y                            | Y                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 23)      | FBH (Ferdinand-Braun-Institut für<br>Höchstfrequenztechnik) HBT model,<br>version 2.1 | Y                 | Y     | Y                            | N                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 230)     | HICUM Level 0   | Y                 | Y     | Y                            | Y                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 234)     | HICUM Level 2   | Y                 | Y     | Y                            | Y                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 504)     | MEXTRAM version 504.12.1  | Y                 | Y     | Y                            | Y                   |  |
| Bipolar Junction Transistor<br>(BJT) (Level 505)     | MEXTRAM version 504.12.1 (with self-heating)  | Y                 | Y     | Y                            | Y                   |  |
| Junction Field Effect Transistor<br>(JFET) (Level 1) | SPICE-compatible JFET model   | Y                 | Y     |                              |                     |  |
| Junction Field Effect Transistor<br>(JFET) (Level 2) | Shockley JFET model   | Y                 | Y     |                              |                     |  |
| MESFET   |   | Y                 | Y     |                              |                     |  |
| MOSFET (Level 1)                                     |   | Y                 | Y     |                              | Y                   |  |
| MOSFET (Level 2)                                     | SPICE level 2 MOSFET  | Y                 | Y     |                              | Y                   |  |
| MOSFET (Level 3)                                     |   | Y                 | Y     |                              | Y                   |  |
| MOSFET (Level 6)                                     | SPICE level 6 MOSFET  | Y                 | Y     |                              | Y                   |  |
| MOSFET (Level 9)                                     | BSIM3 model   | Y                 | Y     | Y                            | Y                   |  |

Table 2-35. Features Supported by Xyce Device Models

| Table 2-33. Features Supported by Ayce Device Models |                               |                   |       |                              |                     |  |
|--|-------------------------------|-------------------|-------|------------------------------|---------------------|--|
| Device   | Comments                      | Branch<br>Current | Power | Analytic<br>Sensi-<br>tivity | Stationary<br>Noise |  |
| MOSFET (Level 10)                                    | BSIM SOI model                | Y                 | Y     |                              |                     |  |
| MOSFET (Level 14 or 54)                              | BSIM4 model                   | Y                 | Y     |                              |                     |  |
| MOSFET (Level 18)                                    | VDMOS general model           | Y                 | Y     |                              |                     |  |
| MOSFET (Level 77)                                    | BSIM6 model version 6.1.1     | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 102)                                   | Legacy PSP model              | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 103)                                   | PSP model                     | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 107)                                   | BSIM-CMG version 107.0.0      | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 110)                                   | BSIM-CMG version 110.0.0      | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 301)                                   | EKV model version 3.0.1       | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 2000)                                  | MVS ETSOI model version 2.0.0 | Y                 | Y     | Y                            | Y                   |  |
| MOSFET (Level 2001)                                  | MVS HEMT model version 2.0.0  | Y                 | Y     | Y                            | Y                   |  |
| Transmission Line (TRA)                              | Lossless                      | Y                 | Y     |                              |                     |  |
| Transmission Line (LTRA)                             | Lossy                         |                   |       |                              |                     |  |
| Lumped Transmission Line                             | Lossy or Lossless             |                   |       |                              |                     |  |
| Controlled Switch (S,W) (VSWITCH/ISWITCH)            | Voltage or current controlled | Y                 | Y     |                              |                     |  |
| Generic Switch (SW)                                  | Controlled by an expression   | Y                 | Y     |                              |                     |  |

Table 2-35. Features Supported by Xyce Device Models

| Device                | Comments  | Branch<br>Current | Power | Analytic<br>Sensi-<br>tivity | Stationary<br>Noise |
|-----------------------|---|-------------------|-------|------------------------------|---------------------|
| PDE Devices (Level 1) | one-dimensional   | Y                 |       |                              |                     |
| PDE Devices (Level 2) | two-dimensional   | Y                 |       |                              |                     |
| Digital (Level 1)     | Behavioral Digital  | NA                | NA    |                              |                     |
| ACC                   | Accelerated mass device, used for simulation of electromechanical and magnetically-driven machines  | NA                | NA    |                              |                     |
| Power Grid            | Separate models for Branch, Bus<br>Shunt, Transformer and Generator<br>Bus. The Generator Bus model<br>supports reactive power (Q) limiting |                   |       |                              |                     |
| Memristor             | TEAM formulation  | Y                 | Y     |                              |                     |
| Memristor             | Yakopcic  | Y                 | Y     |                              |                     |
| Memristor             | PEM Formulation   | Y                 | Y     |                              |                     |

## 2.3.1. Voltage Nodes

Devices in a netlist are connected between *nodes*, and all device types in Xyce require at least two nodes on each instance line. Section 2.3.2 lists the characters that are legal and illegal in Xyce node and device names.

Except for global nodes (below), voltage node names appearing in a subcircuit that are not listed in the subcircuit's argument list are accessible only to that subcircuit; devices outside the subcircuit cannot connect to local nodes.

### 2.3.1.1. Global nodes

A special syntax is used to designate certain nodes as *global* nodes. Any node whose name starts with the two characters "\$G" is a global node, and such nodes are available to be used in any subcircuit. A typical usage of such global nodes is to define a VDD or VSS signal that all subcircuits need to be able to access, but without having to provide VSS and VDD input nodes to every subcircuit. In this case, a global \$GVDD node would be use for the VDD signal.

The node named 0 is a special global node. Node 0 is always ground, and is accessible to all levels of a hierarchical netlist.

For compatibility with HSPICE, the . GLOBAL command can be used to define global nodes that do not start with the two characters "\$G". See section 2.1.11 for more details.

## 2.3.1.2. Subcircuit Nodes

Hierarchical netlists may be created using .SUBCKT [2.1.37] to define common subcircuit types, and X [2.3.33] lines to create instances of those subcircuits. There are two types of nodes associated with such subcircuits, *interface* nodes and *internal* nodes.

Interface nodes are the nodes named on the . SUBCKT line. These are effectively local aliases internal to the subcircuit definition for the node names used on the  ${\tt X}$  instance lines. Internal nodes are nodes inside the subcircuit definition that are strictly local to that subcircuit. Inside a subcircuit, these node names may be used without restriction in device instance lines and expressions on  ${\tt B}$  source lines.

There are some circumstances when it is desirable to access internal nodes of a subcircuit from outside that subcircuit. Xyce provides a syntax that allows this to be done in *some* contexts. The primary context in which this is supported is on <code>.PRINT</code> lines, to allow the user to print out signals that are usually local to a subcircuit.

The syntax used by Xyce to refer to nodes within a subcircuit is to prefix the name of the node with the full path of subcircuit instances in which the node is contained, with colons (:) separating the instance names. So, to reference a node "A" that is inside a subcircuit instance called "Xnot1" inside another subcircuit instance called "Xmain", one would refer to "Xmain:Xnot1:A"

The same syntax works on .PRINT lines even if the subcircuit node is one of the interface nodes on the .SUBCKT line, but those nodes can also be accessed by using the names of the nodes at the higher level of circuit hierarchy that are used on its instance line.

```
* Netlist file demonstrating subcircuit node access
    1
        0
V1
        2
             demosubc
X1
X2.
    2
        \cap
             demosubc
.subckt demosubc A B
R1 A C 1
R2 C B 1
.ends
.dc V1 1 5 1
*V(X1:A) and V(1) are the same signal.
*V(X1:C) is the internal C node of the X1 instance
*V(X2:C) is the internal C node of the X2 instance
\star V(X1:B), V(X2:A) and V(2) are the same signal
.print DC V(X1:C) V(X2:C) V(X1:A) V(1)
                                           V(X1:B) V(X2:A
                                                            V(2)
.end
```

Subcircuit nodes may also be accessed from outside of the subcircuit in  $\[Beta]$  source voltage or current expressions, though this usage violates the strict hierarchy of the netlist. The one difference between this usage and <code>.PRINT</code> usage is that it is not possible to use the subcircuit node syntax to access interface nodes. These must be accessed using the node names being used on the instance line, as in the "V(1)" example in the netlist fragment above.

# 2.3.2. Legal Characters in Node and Device Names

Xyce node names and device names can consist of any printable ASCII characters, with the following exceptions and caveats which may be different than other SPICE-like circuit simulators. The exceptions are:

- White space (space, tab, newline) is not allowed.
- Parentheses ("(" or ")"), braces ("{" or "}"), commas, colons, semi-colons, double quotes and single quotes are also not allowed, since they do not work correctly in node names or device names in all netlist contexts in Xyce.

The caveats are as follows:

- The star (\*) and question mark (?) characters are allowed in both node names and device names. However, those two characters also function as "print wildcards" in Xyce, per section 2.1.31.11. So, that usage is discouraged.
- Global nodes in Xyce begin with the two characters "\$G".
- The node named 0 ("zero") is a special global node, which is always the ground node.
- These arithmetic operators  $% ^ & ? : ~ * + < > / |$  should not be used in node or device names that will be used outside of a Xyce "operator", such as V(), within a Xyce expresson. Examples of this caveat are given below.

• The # character should not be used as the first character of a node name that will be used within an expression. Examples of this caveat are also given below.

These are some examples of the caveats of the use of arithmetic operators and # character within expressions:

```
* Okay since the + in the node name is enclosed within the V() operator. .PRINT TRAN \{V(1+) - V(+)\}
* Okay since the R+ and R- device names are enclosed within the I() operator. .PRINT TRAN \{I(R+) * I(R-)\}
* Okay, for printing the resistance value, since the R-1 device name * is not used in an expression. .PRINT TRAN R-1:R
* Will produce a parsing error, since the R-1 device name is used outside * of an operator. That makes this statement ambiguous within an expression. .PRINT TRAN \{R-1:R\}
* These uses of # are okay. .PRINT TRAN \{V(\#) - 1\}
* These usages of # are parsing errors, since # is the first character * in the node names. .PRINT TRAN \{V(\#) - 2\} \{V(\#1) - 1\}
```

#### 2.3.3. Lead Currents and Power Calculations

For some devices, such as independent voltage and current sources, the current through that device is a "solution" variable. For other devices, the current through the device is a "lead current", whose value is calculated during a post-processing step. This approach has ramifications in Xyce for the availability and accuracy of lead current values. In particular, both lead currents and power calculations need to have been explicitly enabled for a given device, analysis type (e.g., .AC) or netlist command (e.g., .MEASURE).

For voltage sources, both V and I are solution variables. So, their accuracy is more likely to be limited by the nonlinear solver tolerances (RELTOL and ABSTOL). The lead current accuracy, for a device like the resistor, can also be limited by the right-hand side tolerance RHSTOL. So, the calculated lead currents through very small resistances (e.g., 1e-12) may be inaccurate if the default solver tolerances for Xyce are used.

Lead currents have the following additional limitations:

- They are not enabled for . AC analyses.
- They are not allowed in the expression controlling a B-Source.
- They do not work for .RESULT statements.

Lead currents and power calculations are available in .MEASURE and .FOUR statements.

At this time the power calculations are only supported for . DC and . TRAN analysis types and for a limited set of devices. In addition, the results for semiconductor devices (D, J, M, Q and Z devices) and the lossless transmission device (T device) may differ from other simulators. Consult the Features Supported by Xyce Device Models table in section 2.3 and the individual sections on each device for more details.

As an example, the power supplied or dissipated by the voltage source V is calculated as  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

An important note is that the power calculations are also a post-processing step, which places a limit on the accuracy of circuit-wide "energy conservation" calculations (e.g., total power supplied by sources - total power dissipated in non-source devices) in Xyce. The accuracy of the inputs (V and I) to the power calculations is limited by the nonlinear solver and right-hand side tolerances, as noted above, and the error in the power calculations is upper-bounded by the sum of the product-terms of  $V*(error\ in\ I)$  and  $I*(error\ in\ V)$ .

## 2.3.4. Capacitor

## **Symbol**



#### **Instance Form**

C<device name> <(+) node> <(-) node> [model name] [value]
+ [device parameters]

#### **Model Form**

```
.MODEL <model name> C [model parameters]
.MODEL <model name> CAP [model parameters]
```

## **Examples**

```
CM12 2 4 5.288e-13

CLOAD 1 0 4.540pF IC=1.5V

CFEEDBACK 2 0 CMOD 1.0pF

CAGED 2 3 4.0uF D=0.0233 AGE=86200

CSOLDEP 3 0 C={ca*(c0+c1*tanh((V(3,0)-v0)/v1))}

CSOLDEPQ 3 0 Q={ca*(c1*v1*ln(cosh((v(3,0)-v0)/v1))+c0*v(3,0))}
```

## Parameters and Options

### device name

The name of the device.

- (+) node
- (-) node

Polarity definition for a positive voltage across the capacitor. The first node is defined as positive. Therefore, the voltage across the component is the first node voltage minus the second node voltage.

#### model name

If model name is omitted, then value is the capacitance in farads. If [model name] is given then the value is determined from the model parameters; see the capacitor value formula below.

#### value

Positional specification of device parameter C (capacitance). Alternately, this can be specified as a parameter, C=<value>, or in the (optional) model.

### device parameters

Parameters listed in Table 2-36 may be provided as space separated <parameter>=<value> specifications as needed. Any number of parameters may be specified.

### model parameters

Parameters listed in Table 2-37 may be provided as space separated <parameter>=<value> specifications as needed. Any number of parameters may be specified.

#### **Comments**

Positive current flows through the capacitor from the (+) node to the (-) node. In general, capacitors should have a positive capacitance value (<value> property). In all cases, the capacitance must not be zero.

However, cases exist when a negative capacitance value may be used. This occurs most often in filter designs that analyze an RLC circuit equivalent to a real circuit. When transforming from the real to the RLC equivalent, the result may contain a negative capacitance value.

In a transient run, negative capacitance values may cause the simulation to fail due to instabilities they cause in the time integration algorithms.

The power stored or released from the capacitor is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ .

For compatibility with PSpice, either  ${\tt C}$  or CAP can be used in a <code>.MODEL</code> statement for a capacitor.

The Multiplicity Factor (M) can be used to specify multiple, identical capacitors in parallel. The effective capacitance becomes C\*M. The M value need not be an integer. It can be any positive real number. M can not be used as a model parameter.

**Table 2-36. Capacitor Device Instance Parameters** 

| Parameter | Description                        | Units                     | Default                |
|-----------|------------------------------------|---------------------------|------------------------|
| AGE       | Age of capacitor                   | hour                      | 0                      |
| C         | Capacitance                        | F                         | 1e-06                  |
| D         | Age degradation coefficient        | _                         | 0.0233                 |
| IC        | Initial voltage drop across device | V                         | 0                      |
| L         | Semiconductor capacitor width      | m                         | 1                      |
| M         | Multiplicity Factor                | _                         | 1                      |
| Q         | Charge                             | С                         | 0                      |
| TC1       | Linear Temperature Coefficient     | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TC2       | Quadratic Temperature Coefficient  | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TEMP      | Device temperature                 | °C                        | Ambient<br>Temperature |
| W         | Semiconductor capacitor length     | m                         | 1e-06                  |

**Device Parameters** In addition to the parameters shown in the table, the capacitor supports a vector parameter for the temperature correction coefficients. TC1=<linear coefficient> and TC2=<quadratic coefficient> may therefore be specified compactly as TC=<linear coefficient>, <quadratic coefficient>.

**Table 2-37. Capacitor Device Model Parameters** 

| Parameter | Description                       | Units                     | Default                |
|-----------|-----------------------------------|---------------------------|------------------------|
| С         | Capacitance multiplier            |                           | 1                      |
| CJ        | Junction bottom capacitance       | F/m <sup>2</sup>          | 0                      |
| CJSW      | Junction sidewall capacitance     | F/m                       | 0                      |
| DEFW      | Default device width              | m                         | 1e-06                  |
| NARROW    | Narrowing due to side etching     | m                         | 0                      |
| TC1       | Linear temperature coefficient    | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TC2       | Quadratic temperature coefficient | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TNOM      | Nominal device temperature        | °C                        | Ambient<br>Temperature |

#### **Model Parameters**

## **Capacitor Equations**

**Capacitance Value Formula** If [model name] is specified, then the capacitance is given by:

$$\mathbf{C} \cdot (1 + \mathbf{TC1} \cdot (T - T_0) + \mathbf{TC2} \cdot (T - T_0)^2)$$

where  $\mathbb{C}$  is the base capacitance specified on the device line and is normally positive (though it can be negative, but not zero).  $T_0$  is the nominal temperature (set using **TNOM** option).

**Age-aware Formula** If **AGE** is given, then the capacitance is:

$$C[1 - D\log(AGE)]$$

**Semiconductor Formula** If [model name] and L and W are given, then the capacitance is:

$$CJ(L-NARROW)(W-NARROW) + 2 \cdot CJSW(L-W+2 \cdot NARROW)$$

**Solution-Dependent Capacitor** If the capacitance (C) is set equal to an expression then a "solution-dependent" capacitor is used, where the capacitance is a function of other simulation variables. The formulas for temperature-dependence and age-dependence, given above, then use that calculated C value.

If the parameter Q is set equal to an expression *instead* of specifying a capacitance, this expression is used to evaluate the charge on the capacitor instead of computing it from capacitance. Temperature and age dependence are not computed in this case, as these effects are applied by modifying the capacitance.

Both solution-dependent charge and capacitance formulations are implemented to assure charge conservation. The capacitor:

```
c_mcap 1 2 q = \{ca*(c1*v1*ln(cosh((v(1,2)-v0)/v1))+c0*v(1,2))\}
```

is exactly equivalent to the capacitor

```
c_{mcap} 1 2 c= \{ca*(c0+c1*tanh((V(1,2)-v0)/v1))\}
```

because the capacitance is the derivative of the charge with respect to the voltage drop across the capacitor. Similarly, both are equivalent to the behavioral source:

```
BC 1 2 I=ddt(V(1,2))*(ca*(c0+c1*tanh((V(1,2)-v0)/v1)))
```

```
because I = dQ/dt = dQ/dV * dV/dt = C * dV/dt.
```

The restrictions for this formulation are:

- The expression used for C or Q must only use solution variables, which are node voltages and also branch currents for source devices. It may not use device lead currents, which are post-processed quantities that are not solution variables.
- The expression must not use time derivatives.
- Capacitance (C) and Charge (Q) are the only instance or model parameters that are allowed to be solution-dependent.

## **Other Restrictions and Caveats** A netlist parsing error will occur if:

- Neither the C, Q, nor L instance parameters are specified.
- Both C and Q are specified as expressions.
- Q is specified in addition to an IC=.
- The A instance parameter is specified for a semiconductor capacitor (which is specified via L, W and CJSW).

If both the  $\mathbb C$  and  $\mathbb L$  instance parameters are specified then  $\mathbb C$  will be used, rather than the semiconductor formulation.

**Special note on Initial Conditions:** The IC parameter of the capacitor may be used to specify an initial voltage drop on the capacitor. Unlike SPICE3F5, this parameter is never ignored (SPICE3F5 only respects it if UIC is used on a transient line). The initial condition is applied differently depending on the analysis specified.

If one is doing a transient with DC operating point calculation or a DC operating point analysis, the initial condition is applied by inserting a voltage source across the capacitor to force the operating point to find a solution with the capacitor charged to the specific voltage. The resulting operating point will be one that is consistent with the capacitor having the given voltage in steady state.

If one specifies UIC or NOOP on the . TRAN line, then Xyce does not perform an operating point calculation, but rather begins a transient simulation directly given an initial state for the solution. In this case, IC initial conditions are applied only for the first iteration of the Newton solve of the first time step

— the capacitor uses the initial condition to compute its charge, and the nonlinear solver will therefore find a solution to the circuit problem consistent with this charge, i.e., one with the correct voltage drop across the capacitor.

The caveats of this section apply only to initial conditions specified via IC= parameters on the capacitor, and do not affect how initial conditions are applied when using IC= lines to specify initial conditions on node values.

The three different ways of specifying initial conditions can lead to different circuit behaviors. Notably, when applying initial conditions during a DC operating point with IC= on the capacitor line, the resulting operating point will be a DC solution with currents everywhere consistent with there being a constant charge on the capacitor, whereas in general a transient run from an initial condition *without* having performed an operating point calculation will have a quiescent circuit at the first timestep.

#### 2.3.5. Inductor

### **Symbol**

\_\_\_\_\_

#### **Instance Form**

L<name> <(+) node> <(-) node> [model] <value> [device parameters]

#### **Model Form**

.MODEL <model name> L [model parameters]
.MODEL <model name> IND [model parameters]

### **Examples**

L1 1 5 3.718e-08 LM 7 8 L=5e-3 M=2 LLOAD 3 6 4.540mH IC=2mA Lmodded 3 6 indmod 4.540mH

.model indmod L (L=.5 TC1=0.010 TC2=0.0094)

# Parameters and Options

## (+) node

#### (-) node

Polarity definition for a positive voltage across the inductor. The first node is defined as positive. Therefore, the voltage across the component is the first node voltage minus the second node voltage.

#### initial value

The initial current through the inductor during the bias point calculation.

#### **Comments**

In general, inductors should have a positive inductance value. The inductance must not be zero. Also, a netlist parsing error will occur if no value is specified for the inductance.

However, cases exist when a negative value may be used. This occurs most often in filter designs that analyze an RLC circuit equivalent to a real circuit. When transforming from the real to the RLC equivalent, the result may contain a negative inductance value.

The power stored or released from the inductor is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ .

If a model name is given, the inductance is modified from the value given on the instance line by the parameters in the model card. See "Inductance Value Formula" below.

When an inductor is named in the list of coupled inductors in a mutual inductor device line (see page 191), and that mutual inductor is of the nonlinear-core type, the <value> is interpreted as a number of turns rather than as an inductance in Henries.

For compatibility with PSpice, either  ${\tt L}$  or  ${\tt IND}$  can be used in a .MODEL statement for an inductor.

The Multiplicity Factor (M) can be used to specify multiple, identical inductors in parallel. The effective inductance becomes L/M. However, the value for the IC instance parameter is not multiplied by the M value. The M value need not be an integer. It can be any positive real number. M can not be used as a model parameter.

**Table 2-38. Inductor Device Instance Parameters** 

| Parameter | Description                       | Units                     | Default                |
|-----------|-----------------------------------|---------------------------|------------------------|
| IC        | Initial current through device    | A                         | 0                      |
| L         | Inductance                        | henry                     | 0                      |
| M         | Multiplicity Factor               | _                         | 1                      |
| TC1       | Linear Temperature Coefficient    | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TC2       | Quadratic Temperature Coefficient | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TEMP      | Device temperature                | °C                        | Ambient<br>Temperature |

#### **Device Parameters**

**Table 2-39. Inductor Device Model Parameters** 

| Parameter | Description                     | Units                     | Default |
|-----------|---------------------------------|---------------------------|---------|
| IC        | Initial current through device  | A                         | 0       |
| L         | Inductance Multiplier           | _                         | 1       |
| TC1       | First order temperature coeff.  | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TC2       | Second order temperature coeff. | $^{\circ}\mathrm{C}^{-2}$ | 0       |
| TNOM      | Reference temperature           | °C                        | 27      |

**Model Parameters** In addition to the parameters shown in the table, the inductor supports a vector parameter for the temperature correction coefficients. TC1=<linear coefficient> and TC2=<quadratic coefficient> may therefore be specified compactly as TC=<linear coefficient>, <quadratic coefficient>.

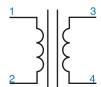
## **Inductor Equations**

**Inductance Value Formula** If [model name] is specified, then the inductance is given by:

$$\mathbf{L}_{base} \cdot \mathbf{L} \cdot (1 + \mathbf{TC1} \cdot (T - T_0) + \mathbf{TC2} \cdot (T - T_0)^2)$$

where  $\mathbf{L}_{base}$  is the base inductance specified on the device line and is normally positive (though it can be negative, but not zero).  $\mathbf{L}$  is the inductance multiplier specified in the model card.  $T_0$  is the nominal temperature (set using **TNOM** option).

#### 2.3.6. Mutual Inductors



### **Symbol**

**Instance Form** 

K<name> L<inductor name> [L<inductor name>\*]
+ <coupling value> [model name]

**Model Form** 

.MODEL <model name> CORE [model parameters]

**Examples** 

ktran1 11 12 13 1.0

KTUNED L3OUT L4IN .8

KTRNSFRM LPRIMARY LSECNDRY 1

KXFRM L1 L2 L3 L4 .98 KPOT\_3C8

## Parameters and Options

#### inductor name

Identifies the inductors to be coupled. The inductors are coupled and in the dot notation the dot is placed on the first node of each inductor. The polarity is determined by the order of the nodes in the L devices and not by the order of the inductors in the K statement.

If more than two inductors are given on a single K line, each inductor is coupled to all of the others using the same coupling value.

### coupling value

The coefficient of mutual coupling, which must be between -1.0 and 1.0.

This coefficient is defined by the equation

$$<$$
coupling value $> = \frac{M_{ij}}{\sqrt{L_i L_j}}$ 

where

 $L_i$  is the inductance of the *i*th named inductor in the K-line

 $M_{ij}$  is the mutual inductance between  $L_i$  and  $L_j$ 

For transformers of normal geometry, use 1.0 as the value. Values less than 1.0 occur in air core transformers when the coils do not completely overlap.

#### model name

If model name is present, four things change:

- The mutual coupling inductor becomes a nonlinear, magnetic core device
- The inductors become windings, so the number specifying inductance now specifies the number of turns.
- The list of coupled inductors could be just one inductor.

- If two or more inductors are listed, each inductor is coupled to all others through the magnetic core.
- A model statement is required to specify the model parameters.

### **Comments**

Lead currents and power calculations are supported for the component inductors in both linear and nonlinear mutual inductors. They are not supported for the composite mutual inductor though. So, if L1 is a component inductor for mutual inductor K1, then requests for I(L1), P(L1) and W(L1) will return lead current and power values as defined in Section 2.3.5. However, any usage of I(K1), P(K1) and W(K1) will result in a Xyce netlist parsing error.

**Table 2-40. Nonlinear Mutual Inductor Device Model Parameters** 

| Parameter        | Description  | Units           | Default   |
|------------------|--|-----------------|-----------|
| А                | Thermal energy parameter   | A/m             | 1000      |
| ALPHA            | Domain coupling parameter  | _               | 5e-05     |
| AREA             | Mean magnetic cross-sectional area   | cm <sup>2</sup> | 0.1       |
| ВЕТАН            | Modeling constant  | _               | 0.0001    |
| BETAM            | Modeling constant  | _               | 3.125e-05 |
| BHSIUNITS        | Flag to report B and H in SI units   | _               | 0         |
| С                | Domain flexing parameter   | _               | 0.2       |
| CLIM             | Value below which domain flexing parameter will be treated as zero.          | _               | 0.005     |
| CONSTDELVSCALING | Use constant scaling factor to smooth voltage difference over first inductor | V               | false     |
| DELVSCALING      | Smoothing coefficient for voltage difference over first inductor             | V               | 1000      |
| FACTORMS         | Flag to factor the saturation magnetization from the magnetics equation.     | -               | 0         |
| GAP              | Effective air gap  | cm              | 0         |
| INCLUDEMEQU      | Flag to include the magnetics in the solution.                               | _               | true      |
| K                | Domain anisotropy parameter  | A/m             | 500       |
| KIRR             | Domain anisotropy parameter  | A/m             | 500       |
| LEVEL            | for pspice compatibility – ignored   | _               | 0         |
| MEQNSCALING      | M-equation scaling   | _               | 1         |
| MS               | Saturation magnetization   | A/m             | 1e+06     |
| MVARSCALING      | M-variable scaling.  | _               | 1         |
| OUTPUTSTATEVARS  | Flag to save state variables   | _               | 0         |
| PACK             | for pspice compatibility – ignored   | _               | 0         |
| PATH             | Total mean magnetic path   | cm              | 1         |
| PZEROTOL         | Tolerance for nonlinear zero crossing  | _               | 0.1       |

Table 2-40. Nonlinear Mutual Inductor Device Model Parameters

| Parameter   | Description                     | Units | Default |
|-------------|---------------------------------|-------|---------|
| REQNSCALING | R-equation scaling              | _     | 1       |
| RVARSCALING | R-variable scaling              | _     | 1       |
| TC1         | First order temperature coeff.  | _     | 0       |
| TC2         | Second order temperature coeff. | _     | 0       |
| TNOM        | Reference temperature           | °C    | 27      |

**Model Parameters** Note that Xyce's default value for the GAP parameter as zero. Some simulators will use non-zero values of the GAP as a default. When using netlists from other simulators in Xyce, ensure that the default parameters are consistent.

**Special Notes** The coupling coefficient of the linear mutual inductor (i.e. a mutual inductor without a core model) is permitted to be a time- or solution variable-dependent expression. This is intended to allow simulation of electromechnical devices in which there might be moving coils that interact with fixed coils.

Additionally, for linear mutual inductors, different coupling terms can be applied to different pairs of inductors with this syntax:

```
L1 1 2 2.0e-3

L2 0 3 8.1e-3

L3 3 4 8.1e-3

ktran1 11 12 0.7

ktran2 12 13 0.9

ktran3 11 13 0.99
```

Nonlinear mutual inductors can output B(t) and H(t) variables so that one can plot B-H loops. On the .print line the B and H variables are accessible using the node output syntax as in n ( non-linear-inductor-name\_b ) for B and n ( non-linear-inductor-name\_h ) for H. A confusing aspect of this is that the non-linear inductor name is the internal name used by Xyce. For example, consider this circuit which defines a nonlinear mutual inductor at both the top level of the circuit and within a subcircuit:

```
* Test Circuit for Mutually Coupled Inductors

VS 0 1 SIN(0 169.7 60HZ)

R1 1 2 1K

R2 3 0 1K

L1 2 0 10

L2 3 0 20

K1 L1 L2 0.75 txmod
.model txmod core
```

```
.subckt mysub n1 n2 n3
r1s n1 n2 1000
r2s n3 0 1000
L1s n2 0 10
L2s n3 0 20
k1s L1s L2s 0.75 txmod
.ends

xtxs 1 4 5 mysub

.TRAN 100US 25MS

* output the current through each inductor and the B & H values.
.PRINT TRAN I(L1) I(L2) n(ymin!k1_b) n(ymin!k1_h)
+ I(xtxs:L1s) I(xtxs:l2s) n(xtxs:ymin!k1s_b) n(xtxs:ymin!k1s_h)
.END
```

The internal, Xyce name of the non-linear mutual inductor is YMIN!K1 or ymin!k1 as the name is not case-sensitive. The device k1s is declared within a subcircuit called xtxs. Thus, its full name is xtxs:ymin!k1s. The reason for this is that both the linear and non-linear mutual inductors are devices that are collections of other devices, inductors in this case. Rather than use one of the few remaining single characters left to signify a new device, Xyce uses Y devices as an indicator of a extended device set, where the characters after the Y denote the device type and then the device name. Here, ymin means a min device which is a mutual-inductor, non-linear device. Thus, to print the B or H variable of the non-linear mutual inductor called k1 one would use n (ymin!k1\_b) and n (ymin!k1\_h) respectively for a .print line that looks like this:

```
.PRINT TRAN I(L1) I(L2) n(ymin!k1_b) n(ymin!k1_h)
```

And if the mutual inductor is in a subcircuit called xtxs then the .print line would look like this:

```
.PRINT TRAN I(xtxs:L1s) I(xtxs:12s) n(xtxs:ymin!k1s_b) n(xtxs:ymin!k1s_h)
```

The above example also demonstrates how one outputs the current through inductors that are part of mutual inductors. The syntax is I ( inductor name ).

Note that while MKS units are used internally in Xyce, B and H are output by default in the SI units of Gauss for B and Oersted for H. To convert B to units of Tesla divide Xyce's output by 10,000. To convert B to units of A/m divide Xyce's output by  $4\pi/1000$ . Additionally, one can set the .model CORE parameter BHSIUNITS to 1 to force B and H to be output in MKS units.

Finally, one can access the B and H data via the .model CORE line. On the nonlinear mutual inductor's .model line, set the option OUTPUTSTATEVARS=1. This will cause Xyce to create a unique file for each nonlinear mutual inductor that uses this .model line with a name of the form Inductor\_device\_name. There are five columns of data in this file: time (t), magnetic moment (M), total current flux (R), flux density (B) and magnetic field strength (H). As with data output on the .print line, SI units are used such that B is output with units of Gauss and H in Oersted. As mentioned earlier, setting the model flag BHSIUNITS to 1 causes the output of B and H uses MKS units of Tesla and A/m respectively.

**Mutual Inductor Equations** The voltage to current relationship for a set of linearly coupled inductors is:

$$V_i = \sum_{j=1}^{N} c_{ij} \sqrt{L_i L_j} \frac{dI_j}{dt}$$
 (2.3)

Here,  $V_i$  is the voltage drop across the *i*th inductor in the coupled set. The coupling coefficient between a pair of inductors is  $c_{ij}$  with a value typically near unity and L is the inductance of a given inductor which has units of Henry's (1  $Henry = 1H = Volt \cdot s/Amp$ )

For nonlinearly coupled inductors, the above equation is expanded to the form:

$$V_{i} = \left[1 + \left(1 - \frac{\ell_{g}}{\ell_{t}}\right) P(M, I_{1}...I_{N})\right] \sum_{j=1}^{N} Lo_{ij} \frac{dI_{j}}{dt}$$
(2.4)

This is similar in form to the linearly coupled inductor equation. However, the coupling has become more complicated as it now depends on the magnetic moment created by the current flow, M. Additionally, there are geometric factors,  $\ell_g$  and  $\ell_t$  which are the effective air gap and total mean magnetic path for the coupled inductors. The matrix of terms,  $Lo_{ij}$  is defined as

$$Lo_{ij} = \frac{\mu_0 A_c N_i N_j}{\ell_t} \tag{2.5}$$

and it represents the physical coupling between inductors i and j. In this expression,  $N_i$  is the number of windings around the core of inductor i,  $\mu_0$  is the magnetic permeability of free space which has units of Henries per meter and a value of  $4\pi \times 10^{-7}$  and  $A_c$  is the mean magnetic cross-sectional area.

The magnetic moment, M is defined by:

$$\frac{dM}{dt} = \frac{1}{\ell_t} P \sum_{i=1}^{N} N_i \frac{dI_i}{dt}$$
 (2.6)

and the function *P* is defined as:

$$P = \frac{cM'_{an} + (1 - c)M'_{irr}}{1 + \left(\frac{\ell_g}{\ell_t} - \alpha\right)cM'_{an} + \frac{\ell_g}{\ell_t}(1 - c)M'_{irr}}$$
(2.7)

If c < CLIM, then c is treated as zero in the above equation and Xyce simplifies the formulation. In this case, the magnetic-moment equation will not be needed and it will be dropped form the formulation. One can controll this behavior by modifying the value of CLIM.

The remaining functions are:

$$M'_{an} = \frac{M_s A}{(A + |H_s|)^2} (2.8)$$

$$H_e = H + \alpha M \tag{2.9}$$

$$H = H_{app} - \frac{\ell_g}{\ell_t} M \tag{2.10}$$

$$H_{app} = \frac{1}{\ell_t} \sum_{i=1}^{N} N_i I_i \tag{2.11}$$

$$M'_{irr} = \frac{\Delta M sgn(q) + |\Delta M|}{2(K_{irr} - \alpha |\Delta M|)}$$
(2.12)

$$\Delta M = M_{an} - M \tag{2.13}$$

$$\Delta M = M_{an} - M$$

$$M_{an} = \frac{M_s H_e}{A + |H_e|}$$
(2.13)

$$q = \text{DELVSCALING}\Delta V$$
 (2.15)

Xyce dynamically modifies DELVSCALING to be 1000/ Maximum Voltage Drop over the first inductor. This typically produces accurate results for both low voltage and high voltage applications. However, it is possible to use a fixed scaling by setting the model parameter CONSTDELVSCALING to true and then setting DELVSCALING to the desired scaling value.

In Xyce's formulation, we define *R* as:

$$R = \frac{dH_{app}}{dt} = \frac{1}{\ell_t} \sum_{i=1}^{N} N_i \frac{dI_i}{dt}$$
 (2.16)

This simplifies the *M* equation to:

$$\frac{dM}{dt} = PR \tag{2.17}$$

Xyce then solves for the additional variables M and R when modeling a nonlinear mutual inductor device.

**B-H Loop Calculations** To calculate *B-H* loops, *H* is used as defined above and *B* is a derived quantity calculated by:

$$B = \mu_0 (H + M) \tag{2.18}$$

$$= \mu_0 \left[ H_{app} + \left( 1 - \frac{\ell_g}{\ell_t} \right) M \right] \tag{2.19}$$

Converting Nonlinear to Linear Inductor Models At times one may have a model for nonlinear mutual inductor, but wish to use a simpler linear model in a given circuit. To convert a non-linear model to an equivalent linear form, one can start by equating the coupling components of equations 2.3 and 2.4 as:

$$c_{ij}\sqrt{L_iL_j} = \left[1 + \left(1 - \frac{\ell_g}{\ell_t}\right)P(M, I_1...I_N)\right]Lo_{ij}$$
(2.20)

In the above relationship, i and j represent the ith and jth inductors. Since we would like to equate the ith inductor's nonliner properties to its linear properties, we will substitute  $i \rightarrow j$  and simplify assuming steady state where d/dt = 0 and M(t) = 0.

$$L_{i} = \frac{1}{c_{ii}} \left\{ 1 + \left( 1 - \frac{\ell_{g}}{\ell_{t}} \right) \left[ \frac{c \frac{Ms}{A}}{1 + \left( \frac{\ell_{g}}{\ell_{t}} - \alpha \right) \frac{Ms}{A}} \right] \right\} \frac{\mu A_{c}}{\ell_{t}} N_{i}^{2}$$

$$(2.21)$$

In the above equatin,  $c_{ii}$  represents the coupling coefficient between the *i*th inductor with itself. This will likely be 1 unless there are very unusual geometry considerations. Note, that the terms A, Ms,  $A_c$ ,  $\mu$ ,  $\ell_g$  and  $\ell_t$  all have units of length within them and must use the same unit for this relationship to be valid. Specifically,  $\mu$  has units of Henery's per meter and A and Ms have units of Amps per meter.  $A_c$ ,  $\ell_g$  and  $\ell_p$ 

have units of length<sup>2</sup> and length respectively, but the length unit used in the model statement is  $cm^2$  and cm respectively. Thus, one must use consistent units such as meters for  $A_c$ ,  $\ell_g$  and  $\ell_p$  in equation 2.21 for a valid inductance approximation.

#### 2.3.7. Resistor

| C    | - L - I |
|------|---------|
| SVII | 1bol    |
|      |         |

**-**WV--

#### **Instance Form**

R<name> <(+) node> <(-) node> [model name] [value]

[device parameters]

#### **Model Form**

.MODEL <model name> R [model parameters]
.MODEL <model name> RES [model parameters]

## **Examples**

R1 1 2 2K TEMP=27 RM 4 5 R=4e3 M=2

RSOLDEP 2 0 R={1.0+scalar\*V(1)} RLOAD 3 6 RTCMOD 4.540 TEMP=85 .MODEL RTCMOD R (TC1=.01 TC2=-.001) RSEMICOND 2 0 RMOD L=1000u W=1u .MODEL RMOD R (RSH=1)

## Parameters and Options

#### (+) node

#### (-) node

Polarity definition for a positive voltage across the resistor. The first node is defined as positive. Therefore, the voltage across the component is the first node voltage minus the second node voltage. Positive current flows from the positive node (first node) to the negative node (second node).

#### model name

If [model name] is omitted, then [value] is the resistance in Ohms. If [model name] is given then the resistance is determined from the model parameters; see the resistance value formula below.

#### value

Positional specification of device parameter R (resistance). Alternately, this can be specified as a parameter, R=<value>, or in the (optional) model.

### device parameters

Parameters listed in Table 2-41 may be provided as space separated <parameter>=<value> specifications as needed. Any number of parameters may be specified.

#### **Comments**

Resistors can have either positive or negative resistance values (R). A zero resistance value (R) is also allowed.

The power dissipated in the resistor is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . The power accessors (P () and W ()) are supported for both the level 1 resistor and the level 2 (thermal) resistor.

For compatibility with PSpice, either  ${\tt R}$  or  ${\tt RES}$  can be used in a  $\, {\tt .MODEL}$  statement for a resistor.

The Multiplicity Factor (M) can be used to specify multiple, identical resistors in parallel. The effective resistance becomes R/M. The M value need not be an integer. It can be any positive real number. M can not be used as a model parameter.

**Table 2-41. Resistor Device Instance Parameters** 

| Parameter | Description   | Units                     | Default                |
|-----------|---|---------------------------|------------------------|
| DTEMP     | Device Temperature – For compatibility only.<br>Parameter is NOT used | °C                        | 0                      |
| L         | Length  | m                         | 0                      |
| M         | Multiplicity Factor   | _                         | 1                      |
| R         | Resistance  | Ω                         | 1000                   |
| TC1       | Linear Temperature Coefficient  | $^{\circ}C^{-1}$          | 0                      |
| TC2       | Quadratic Temperature Coefficient                                     | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TCE       | Exponential Temperature Coefficient                                   | %/°C                      | 0                      |
| TEMP      | Device temperature  | °C                        | Ambient<br>Temperature |
| W         | Width   | m                         | 0                      |

**Device Parameters** In addition to the parameters shown in the table, the resistor supports a vector parameter for the temperature correction coefficients. TC1=<linear coefficient> and TC2=<quadratic coefficient> may therefore be specified compactly as TC=<linear coefficient>, <quadratic coefficient>.

Table 2-42. Resistor Device Model Parameters

| Parameter | Description                         | Units                     | Default                |
|-----------|-------------------------------------|---------------------------|------------------------|
| DEFW      | Default Instance Width              | m                         | 1e-05                  |
| NARROW    | Narrowing due to side etching       | m                         | 0                      |
| R         | Resistance Multiplier               | _                         | 1                      |
| RSH       | Sheet Resistance                    | Ω                         | 0                      |
| TC1       | Linear Temperature Coefficient      | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TC2       | Quadratic Temperature Coefficient   | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TCE       | Exponential Temperature Coefficient | %/°C                      | 0                      |
| TNOM      | Parameter Measurement Temperature   | °C                        | Ambient<br>Temperature |

**Model Parameters** Note: There is no model parameter for Default Instance Length. The use of the semiconductor resistor model requires the user to specify a non-zero value for the instance parameter L.

## **Resistor Equations**

**Resistance Value Formulas** If the R parameter is given on the device instance line then that value is used.

If the **R** parameter is not given then the semiconductor resistor model will be used if the **L** instance parameter and the **RSH** model parameter are given and both are non-zero. In that case the resistance will be as follows. (Note: If **W** is not given on the instance line then the value for the model parameter **DEFW** will be used instead.)

$$RSH\frac{[L-NARROW]}{[W-NARROW]}$$

If neither of these two cases apply then the default value for the **R** parameter will be used.

**Temperature Dependence** If **TCE** is specified as either an instance or model parameter for the Level 1 resistor then the resistance at temperature T is given by (where the resistance at the nominal temperature  $(T_0)$  was defined above in the resistance value formulas):

$$\mathbf{R} \cdot pow(1.01, \mathbf{TCE} \cdot (T - T_0))$$

otherwise the resistance is given by:

$$\mathbf{R} \cdot (1 + \mathbf{TC1} \cdot (T - T_0) + \mathbf{TC2} \cdot (T - T_0)^2)$$

**Thermal (level=2) Resistor** Xyce supports a thermal resistor model, which is associated with level=2.

Table 2-43. Resistor Device Instance Parameters

| Parameter            | Description   | Units                        | Default                |
|----------------------|---|------------------------------|------------------------|
| A                    | Area of conductor   | $m^2$                        | 0                      |
| DENSITY              | Resistor material density (unused)                                  | kg/m <sup>3</sup>            | 0                      |
| HEATCAPACITY         | Resistor material volumetric heat capacity                          | $J/(m^3K)$                   | 0                      |
| L                    | Length of conductor   | m                            | 0                      |
| M                    | Multiplicity Factor   | _                            | 1                      |
| OUTPUTINTVARS        | Debug Output switch   | _                            | false                  |
| R                    | Resistance  | Ω                            | 1000                   |
| RESISTIVITY          | Resistor material resistivity                                       | Ωm                           | 0                      |
| TEMP                 | Device temperature  | °C                           | Ambient<br>Temperature |
| THERMAL_A            | Area of material thermally coupled to conductor                     | m <sup>2</sup>               | 0                      |
| THERMAL_HEATCAPACITY | Volumetric heat capacity of material thermally coupled to conductor | $J/(\mathrm{m}^3\mathrm{K})$ | 0                      |
| THERMAL_L            | Length of material thermally coupled to conductor                   | m                            | 0                      |
| W                    | Width of conductor  | m                            | 0                      |

#### **Thermal Resistor Instance Parameters**

**Table 2-44. Resistor Device Model Parameters** 

| Parameter            | Description   | Units                        | Default                |
|----------------------|---|------------------------------|------------------------|
| DEFW                 | Default Instance Width  | m                            | 1e-05                  |
| DENSITY              | Resistor material density (unused)                                  | kg/m <sup>3</sup>            | 0                      |
| HEATCAPACITY         | Resistor material volumetric heat capacity                          | $J/(m^3K)$                   | 0                      |
| NARROW               | Narrowing due to side etching                                       | m                            | 0                      |
| R                    | Resistance Multiplier   | _                            | 1                      |
| RESISTIVITY          | Resistor material resistivity                                       | Ωm                           | 0                      |
| RSH                  | Sheet Resistance  | Ω                            | 0                      |
| TC1                  | Linear Temperature Coefficient                                      | $^{\circ}\mathrm{C}^{-1}$    | 0                      |
| TC2                  | Quadratic Temperature Coefficient                                   | $^{\circ}\mathrm{C}^{-2}$    | 0                      |
| TCE                  | Exponential Temperature Coefficient                                 | %/°C                         | 0                      |
| THERMAL_HEATCAPACITY | Volumetric heat capacity of material thermally coupled to conductor | $J/(\mathrm{m}^3\mathrm{K})$ | 0                      |
| TNOM                 | Nominal device temperature  | °C                           | Ambient<br>Temperature |

**Thermal Resistor Model Parameters** The temperature model for the thermal resistor will be enabled if the **A** and **L** instance parameters are given and the parameters **HEATCAPACITY** and **RESISTIVITY** are also given as a pair of either instance parameters or model parameters. Otherwise, the resistance value and temperature dependence of the Level 2 resistor will follow the equations for the Level 1 resistor given above, with the caveat that TCE is only allowed as a model parameter for the Level 2 resistor.

If the temperature model for the Level 2 resistor is enabled, then the resistance (R) is given by the following, where the **RESISTIVITY** can be a temperature-dependent expression:

$$\frac{\text{RESISTIVITY} \cdot \mathbf{L}}{\mathbf{A}}$$

The rate-of-change (dT/dt) of the temperature (T) of the thermal resistor with time is then given by the following where  $i_0$  is the current through the resistor:

$$\frac{i_0 \cdot i_0 \cdot R}{(\mathbf{A} \cdot \mathbf{L} \cdot \mathbf{HEATCAPACITY}) + (\mathbf{THERMAL\_A} \cdot \mathbf{THERMAL\_L} \cdot \mathbf{THERMAL\_HEATCAPACITY})}$$

**Solution-Dependent Resistor** If the resistance (R) is set equal to an expression then a "solution-dependent" resistor is used, where the resistor is a function of other simulation variables. The formulas for temperature-dependence, given above, then use that calculated R value.

The restrictions for this solution dependent resistors are:

- The expression used for R must only use solution variables, which are node voltages and also branch currents for source devices. It may not use device lead currents, which are post-processed quantities that are not solution variables.
- The expression must not use time derivatives.
- Resistance (R) is the only instance or model parameters that are allowed to be solution-dependent.

#### 2.3.8. Diode

Symbol

Instance Form D<name> <(+) node> <(-) node> <model name> [area value]

Model Form .MODEL <model name> D [model parameters]

Examples DCLAMP 1 0 DMOD

D2 15 17 SWITCH 1.5

## Parameters and Options

- (+) node
- (-) node

The anode and the cathode.

area value

Scales IS, ISR, IKF, RS, CJO, and IBV, and has a default value of 1. IBV and BV are both specified as positive values.

#### **Comments**

The diode is modeled as an ohmic resistance (RS/area) in series with an intrinsic diode. Positive current is current flowing from the anode through the diode to the cathode.

The power through the diode is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . This formula may differ from other simulators, such as HSPICE.

**Diode Operating Temperature** Model parameters can be assigned unique measurement temperatures using the **TNOM** model parameter.

**Diode level selection** Three distinct implementations of the diode are available. These are selected by using the LEVEL model parameter. The default implementation is based on SPICE 3F5, and may be explicitly specified using LEVEL=1 in the model parameters, but is also selected if no LEVEL parameter is specified. The PSpice implementation [2] is obtained by specifying LEVEL=2. The Xyce LEVEL=200 diode is the JUNCAP200 model. The Xyce LEVEL=2002 diode is the DIODE\_CMC model version 2.0.0.

The Xyce LEVEL=1 and LEVEL=2 diodes have a parameter, IRF, that allows the user to adjust the reverse current from the basic SPICE implementation. The usual SPICE treatment defines the linear portion of the reverse current in terms of IS which is defined by the forward current characteristics. Data shows that often the reverse current is quite far off when determined in this manner. The parameter IRF is a multiplier that can be applied to adjust the linear portion of the reverse current. NOTE: The adjustment applied when IRF is specified is not well validated and is known in some circumstances to cause non-physical solution discontinuities and/or simulation failure. It is a deprecated feature as of Xyce 6.11, and may

be removed in a future release. If IRF is left unspecified, the diode reverts to being compatible with the SPICE3F5 diode model. If IRF is specified in the model card, even if the default value of 1.0 is used in the specification, a temperature correction factor is applied that makes the device incompatible with SPICE3F5's model. For this reason, any specification of IRF in the model card will result in a warning from versions of Xyce after 6.11.

**Table 2-45. Diode Device Instance Parameters** 

| Parameter | Description   | Units            | Default                |
|-----------|---|------------------|------------------------|
| AREA      | Area scaling value (scales IS, ISR, IKF, RS, CJ0, and IBV)  | -                | 1                      |
| IC        |   | _                | 0                      |
| LAMBERTW  | Option to solve diode equations with the Lambert-W function | logical<br>(T/F) | 0                      |
| M         | multiplicity factor   | _                | 1                      |
| OFF       | Initial voltage drop across device set to zero              | logical<br>(T/F) | 0                      |
| TEMP      | Device temperature  | -                | Ambient<br>Temperature |

## **Level 1 and 2 Diode Instance Parameters**

**Table 2-46. Diode Device Model Parameters** 

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| AF        | Flicker noise exponent                                | -     | 1       |
| BV        | Reverse breakdown "knee" voltage                      | V     | 1e+99   |
| CJ        | Zero-bias p-n depletion capacitance                   | F     | 0       |
| СЈ0       | Zero-bias p-n depletion capacitance                   | F     | 0       |
| СЈО       | Zero-bias p-n depletion capacitance                   | F     | 0       |
| EG        | Bandgap voltage (barrier height)                      | eV    | 1.11    |
| FC        | Forward-bias depletion capacitance coefficient        | _     | 0.5     |
| IBV       | Reverse breakdown "knee" current                      | A     | 0.001   |
| IBVL      | Low-level reverse breakdown "knee" current (level 2)  | A     | 0       |
| IKF       | High-injection "knee" current (level 2)               | A     | 0       |
| IRF       | Reverse current fitting factor                        | _     | 1       |
| IS        | Saturation current                                    | A     | 1e-14   |
| ISR       | Recombination current parameter (level 2)             | A     | 0       |
| JS        | Saturation current                                    | A     | 1e-14   |
| KF        | Flicker noise coefficient                             | _     | 0       |
| M         | Grading parameter for p-n junction                    | _     | 0.5     |
| N         | Emission coefficient                                  | _     | 1       |
| NBV       | Reverse breakdown ideality factor (level 2)           | _     | 1       |
| NBVL      | Low-level reverse breakdown ideality factor (level 2) | _     | 1       |
| NR        | Emission coefficient for ISR (level 2)                | _     | 2       |
| RS        | Parasitic resistance                                  | Ω     | 0       |

**Table 2-46. Diode Device Model Parameters** 

| Parameter | Description                                      | Units                     | Default                |
|-----------|--|---------------------------|------------------------|
| TBV1      | BV temperature coefficient (linear) (level 2)    | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TBV2      | BV temperature coefficient (quadratic) (level 2) | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TIKF      | IKF temperature coefficient (linear) (level 2)   | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TNOM      |  |                           | Ambient<br>Temperature |
| TRS1      | RS temperature coefficient (linear) (level 2)    | $^{\circ}\mathrm{C}^{-1}$ | 0                      |
| TRS2      | RS temperature coefficient (quadratic) (level 2) | $^{\circ}\mathrm{C}^{-2}$ | 0                      |
| TT        | Transit time                                     | S                         | 0                      |
| VB        | Reverse breakdown "knee" voltage                 | V                         | 1e+99                  |
| VJ        | Potential for p-n junction                       | V                         | 1                      |
| XTI       | IS temperature exponent                          |                           | 3                      |

#### Level 1 and 2 Diode Model Parameters

**JUNCAP200** (level=200) Parameters The JUNCAP200 model has the instance and model parameters in the tables below. Complete documentation of JUNCAP200 may be found at http://www.cea.fr/cea-tech/leti/pspsupport/Documents/juncap200p5\_summary.pdf.

The JUNCAP200 device supports output of the internal variables in table 2-49 on the .PRINT line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific level 200 D device in your netlist.

Table 2-47. JUNCAP200 Diode Device Instance Parameters

| Parameter | Description                          | Units | Default |
|-----------|--------------------------------------|-------|---------|
| AB        | Junction area                        | $m^2$ | 1e-12   |
| LG        | Gate-edge part of junction perimeter | $m^2$ | 1e-06   |
| LS        | STI-edge part of junction perimeter  | $m^2$ | 1e-06   |
| М         | Alias for MULT                       | _     | 1       |
| MULT      | Number of devices in parallel        | _     | 1       |

Table 2-48. JUNCAP200 Diode Device Model Parameters

| Parameter | Description   | Units             | Default |
|-----------|---|-------------------|---------|
| СВВТВОТ   | Band-to-band tunneling prefactor of bottom component    | A/V <sup>3</sup>  | 1e-12   |
| CBBTGAT   | Band-to-band tunneling prefactor of gate-edge component | Am/V <sup>3</sup> | 1e-18   |
| CBBTSTI   | Band-to-band tunneling prefactor of STI-edge component  | Am/V <sup>3</sup> | 1e-18   |

Table 2-48. JUNCAP200 Diode Device Model Parameters

| Parameter  | Description  | Units              | Default |
|------------|--|--------------------|---------|
| CJORBOT    | Zero-bias capacitance per unit-of-area of bottom component   | F/m <sup>2</sup>   | 0.001   |
| CJORGAT    | Zero-bias capacitance per unit-of-length of gate-edge component                                    | F/m                | 1e-09   |
| CJORSTI    | Zero-bias capacitance per unit-of-length of STI-edge component                                     | F/m                | 1e-09   |
| CSRHBOT    | Shockley-Read-Hall prefactor of bottom component   | A/m <sup>3</sup>   | 100     |
| CSRHGAT    | Shockley-Read-Hall prefactor of gate-edge component  | A/m <sup>2</sup>   | 0.0001  |
| CSRHSTI    | Shockley-Read-Hall prefactor of STI-edge component   | A/m <sup>2</sup>   | 0.0001  |
| СТАТВОТ    | Trap-assisted tunneling prefactor of bottom component  | A/m <sup>3</sup>   | 100     |
| CTATGAT    | Trap-assisted tunneling prefactor of gate-edge component   | A/m <sup>2</sup>   | 0.0001  |
| CTATSTI    | Trap-assisted tunneling prefactor of STI-edge component  | A/m <sup>2</sup>   | 0.0001  |
| DTA        | Temperature offset with respect to ambient temperature   | K                  | 0       |
| FBBTRBOT   | Normalization field at the reference temperature for band-to-band tunneling of bottom component    | $Vm^{-1}$          | 1e+09   |
| FBBTRGAT   | Normalization field at the reference temperature for band-to-band tunneling of gate-edge component | $\mathrm{Vm^{-1}}$ | 1e+09   |
| FBBTRSTI   | Normalization field at the reference temperature for band-to-band tunneling of STI-edge component  | $Vm^{-1}$          | 1e+09   |
| FJUNQ      | Fraction below which junction capacitance components are considered negligible                     | _                  | 0.03    |
| FREV       | Coefficient for reverse breakdown current limitation   | _                  | 1000    |
| IDSATRBOT  | Saturation current density at the reference temperature of bottom component                        | A/m <sup>2</sup>   | 1e-12   |
| IDSATRGAT  | Saturation current density at the reference temperature of gate-edge component                     | A/m                | 1e-18   |
| IDSATRSTI  | Saturation current density at the reference temperature of STI-edge component                      | A/m                | 1e-18   |
| IMAX       | Maximum current up to which forward current behaves exponentially                                  | A                  | 1000    |
| LEVEL      | Model level must be 200  |                    | 200     |
| MEFFTATBOT | Effective mass (in units of m0) for trap-assisted tunneling of bottom component                    | _                  | 0.25    |
| MEFFTATGAT | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component                 | _                  | 0.25    |

Table 2-48. JUNCAP200 Diode Device Model Parameters

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| MEFFTATSTI | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component | _     | 0.25    |
| PBOT       | Grading coefficient of bottom component   | _     | 0.5     |
| PBRBOT     | Breakdown onset tuning parameter of bottom component                              | V     | 4       |
| PBRGAT     | Breakdown onset tuning parameter of gate-edge component                           | V     | 4       |
| PBRSTI     | Breakdown onset tuning parameter of STI-edge component                            | V     | 4       |
| PGAT       | Grading coefficient of gate-edge component  | _     | 0.5     |
| PHIGBOT    | Zero-temperature bandgap voltage of bottom component                              | V     | 1.16    |
| PHIGGAT    | Zero-temperature bandgap voltage of gate-edge component                           | V     | 1.16    |
| PHIGSTI    | Zero-temperature bandgap voltage of STI-edge component                            | V     | 1.16    |
| PSTI       | Grading coefficient of STI-edge component   | _     | 0.5     |
| STFBBTBOT  | Temperature scaling parameter for band-to-band tunneling of bottom component      | 1/K   | -0.001  |
| STFBBTGAT  | Temperature scaling parameter for band-to-band tunneling of gate-edge component   | 1/K   | -0.001  |
| STFBBTSTI  | Temperature scaling parameter for band-to-band tunneling of STI-edge component    | 1/K   | -0.001  |
| SWJUNEXP   | Flag for JUNCAP-express; 0=full model, 1=express model                            | _     | 0       |
| ΓRJ        | Reference temperature   | °C    | 21      |
| YPE        | Type parameter, in output value 1 reflects n-type, -1 reflects p-type             | _     | 1       |
| /BIRBOT    | Built-in voltage at the reference temperature of bottom component                 | V     | 1       |
| /BIRGAT    | Built-in voltage at the reference temperature of gate-edge component              | V     | 1       |
| /BIRSTI    | Built-in voltage at the reference temperature of STI-edge component               | V     | 1       |
| /BRBOT     | Breakdown voltage of bottom component   | V     | 10      |
| BRGAT      | Breakdown voltage of gate-edge component  | V     | 10      |
| BRSTI      | Breakdown voltage of STI-edge component   | V     | 10      |
| /JUNREF    | Typical maximum junction voltage; usually about 2*VSUP                            | V     | 2.5     |
| KJUNGAT    | Junction depth of gate-edge component   | m     | 1e-07   |

Table 2-48. JUNCAP200 Diode Device Model Parameters

| Parameter | Description                          | Units | Default |
|-----------|--------------------------------------|-------|---------|
| XJUNSTI   | Junction depth of STI-edge component | m     | 1e-07   |

Table 2-49. Diode level 200 Output Variables

| Parameter | Description                                   | Units              | Default |
|-----------|---|--------------------|---------|
| vak       | Voltage between anode and cathode             | V                  | none    |
| cj        | Total source junction capacitance             | F                  | none    |
| cjbot     | Junction capacitance (bottom component)       | F                  | none    |
| cjgat     | Junction capacitance (gate-edge component)    | F                  | none    |
| cjsti     | Junction capacitance (STI-edge component)     | F                  | none    |
| ij        | Total source junction current                 | A                  | none    |
| ijbot     | Junction current (bottom component)           | A                  | none    |
| ijgat     | Junction current (gate-edge component)        | A                  | none    |
| ijsti     | Junction current (STI-edge component)         | A                  | none    |
| si        | Total junction current noise spectral density | A <sup>2</sup> /Hz | none    |
| idsatsbot | Total bottom saturation current               | A                  | none    |
| idsatssti | Total STI-edge saturation current             | A                  | none    |
| idsatsgat | Total gate-edge saturation current            | A                  | none    |
| cjosbot   | Total bottom capacity                         | F                  | none    |
| cjossti   | Total STI-edge capacity                       | F                  | none    |
| cjosgat   | Total gate-edge capacity                      | F                  | none    |
| vbisbot   | built-in voltage of the bottom junction       | V                  | none    |
| vbissti   | built-in voltage of the STI-edge junction     | V                  | none    |
| vbisgat   | built-in voltage of the gate-edge junction    | V                  | none    |

**DIODE\_CMC** (level=2002) Parameters The DIODE\_CMC model has the instance and model parameters in the tables below. Complete documentation of DIODE\_CMC may be found at https://si2.org/standard-models.

The DIODE\_CMC device supports output of the internal variables in table 2-52 on the .PRINT line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific level 200 D device in your netlist.

Table 2-50. ADMS DIODE\_CMC Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---------------|-------|---------|
| AB        | Junction area | -     | 1e-12   |
| AREA      | Alias for AB  | _     | 1e-12   |

Table 2-50. ADMS DIODE\_CMC Device Instance Parameters

| Parameter | Description                          | Units | Default |
|-----------|--------------------------------------|-------|---------|
| LG        | Gate-edge part of junction perimeter | -     | 0       |
| LS        | STI-edge part of junction perimeter  | _     | 1e-06   |
| MULT      | Number of devices in parallel        | _     | 1       |
| PERIM     | Alias for LS                         | _     | 1e-06   |
| PJ        | Alias for LS                         | _     | 1e-06   |

Table 2-51. ADMS DIODE\_CMC Device Model Parameters

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| ABMAX      | maximum allowed junction area   | _     | 1       |
| ABMIN      | minimum allowed junction area   | _     | 0       |
| AF         | AF parameter for flicker noise  | _     | 1       |
| СВВТВОТ    | Band-to-band tunneling prefactor of bottom component  | _     | 1e-12   |
| CBBTGAT    | Band-to-band tunneling prefactor of gate-edge component   | -     | 1e-18   |
| CBBTSTI    | Band-to-band tunneling prefactor of STI-edge component  | _     | 1e-18   |
| CJORBOT    | Zero-bias capacitance per unit-of-area of bottom component                                      | _     | 0.001   |
| CJORGAT    | Zero-bias capacitance per unit-of-length of gate-edge component                                 | _     | 1e-09   |
| CJORSTI    | Zero-bias capacitance per unit-of-length of STI-edge component                                  | _     | 1e-09   |
| CORECOVERY | Flag for recovery equations; 0=original, 1=Hiroshima  | _     | 0       |
| CSRHBOT    | Shockley-Read-Hall prefactor of bottom component  | _     | 100     |
| CSRHGAT    | Shockley-Read-Hall prefactor of gate-edge component   | _     | 0.0001  |
| CSRHSTI    | Shockley-Read-Hall prefactor of STI-edge component  | _     | 0.0001  |
| СТАТВОТ    | Trap-assisted tunneling prefactor of bottom component   | _     | 100     |
| CTATGAT    | Trap-assisted tunneling prefactor of gate-edge component  | _     | 0.0001  |
| CTATSTI    | Trap-assisted tunneling prefactor of STI-edge component   | _     | 0.0001  |
| DEPNQS     | Depletion delay time  | _     | 0       |
| DTA        | Temperature offset with respect to ambient temperature  | _     | 0       |
| FBBTRBOT   | Normalization field at the reference temperature for band-to-band tunneling of bottom component |       | 1e+09   |

Table 2-51. ADMS DIODE\_CMC Device Model Parameters

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| FBBTRGAT   | Normalization field at the reference temperature for band-to-band tunneling of gate-edge component | -     | 1e+09   |
| FBBTRSTI   | Normalization field at the reference temperature for band-to-band tunneling of STI-edge component  | -     | 1e+09   |
| FJUNQ      | Fraction below which junction capacitance components are considered negligible                     | _     | 0.03    |
| FREV       | Additional parameter for current after breakdown   | _     | 1000    |
| IDSATRBOT  | Saturation current density at the reference temperature of bottom component                        | _     | 1e-12   |
| IDSATRGAT  | Saturation current density at the reference temperature of gate-edge component                     | _     | 1e-18   |
| IDSATRSTI  | Saturation current density at the reference temperature of STI-edge component                      | _     | 1e-18   |
| IMAX       | Maximum current up to which forward current behaves exponentially                                  | _     | 1000    |
| INJ1       | For carrier density  | _     | 1       |
| INJ2       | For carrier density in high-injection condition  | _     | 10      |
| INJT       | Temp. co of carrier density in high-injection condition  | _     | 0       |
| KF         | KF parameter for flicker noise   | _     | 0       |
| LGMAX      | maximum allowed junction gate-edge   | _     | 1       |
| LGMIN      | minimum allowed junction gate-edge   | _     | 0       |
| LSMAX      | maximum allowed junction STI-edge  | _     | 1       |
| LSMIN      | minimum allowed junction STI-edge  | _     | 0       |
| MEFFTATBOT | Effective mass (in units of m0) for trap-assisted tunneling of bottom component                    | _     | 0.25    |
| MEFFTATGAT | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component                 | _     | 0.25    |
| MEFFTATSTI | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component                  | _     | 0.25    |
| NDIBOT     | Doping concentration of drift region   | _     | 1e+16   |
| NDIGAT     | Doping concentration of drift region   | _     | 1e+16   |
| NDISTI     | Doping concentration of drift region   | _     | 1e+16   |
| NFABOT     | ideality factor bottom component   | _     | 1       |
| NFAGAT     | ideality factor gate-edge component  |       | 1       |
| NFASTI     | ideality factor STI-edge component   | _     | 1       |
| NJDV       | Transition slope of emission coefficient   | _     | 0.1     |
| NJH        | High-injection emission coefficient  | _     | 1       |
| NQS        | Carrier delay time   |       | 5e-09   |
| PBOT       | Grading coefficient of bottom component  | _     | 0.5     |

Table 2-51. ADMS DIODE\_CMC Device Model Parameters

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| PBRBOT     | Breakdown onset tuning parameter of bottom component                            | -     | 4       |
| PBRGAT     | Breakdown onset tuning parameter of gate-edge component                         | -     | 4       |
| PBRSTI     | Breakdown onset tuning parameter of STI-edge component                          | -     | 4       |
| PGAT       | Grading coefficient of gate-edge component                                      | _     | 0.5     |
| PHIGBOT    | Zero-temperature bandgap voltage of bottom component                            | -     | 1.16    |
| PHIGGAT    | Zero-temperature bandgap voltage of gate-edge component                         | -     | 1.16    |
| PHIGSTI    | Zero-temperature bandgap voltage of STI-edge component                          | -     | 1.16    |
| PSTI       | Grading coefficient of STI-edge component                                       | _     | 0.5     |
| PT         | Alias for XTI   | _     | 3       |
| REVISION   | Model revision  | _     | 0       |
| RSBOT      | Series resistance per unit-of-area of bottom component                          | -     | 0       |
| RSCOM      | Common series resistance, no scaling  | _     | 0       |
| RSGAT      | Series resistance per unit-of-length of gate-edge component                     | -     | 0       |
| RSSTI      | Series resistance per unit-of-length of STI-edge component                      | -     | 0       |
| SCALE      | Scale parameter   | _     | 1       |
| SHRINK     | Scale parameter   | _     | 0       |
| STFBBTBOT  | Temperature scaling parameter for band-to-band tunneling of bottom component    | -     | -0.001  |
| STFBBTGAT  | Temperature scaling parameter for band-to-band tunneling of gate-edge component | -     | -0.001  |
| STFBBTSTI  | Temperature scaling parameter for band-to-band tunneling of STI-edge component  | -     | -0.001  |
| STRS       | Temperature scaling parameter for series resistance                             | _     | 0       |
| STVBRBOT1  | Temp. co of breakdown voltage bottom component                                  | _     | 0       |
| STVBRBOT2  | Temp. co of breakdown voltage bottom component                                  | _     | 0       |
| STVBRGAT1  | Temp. co of breakdown voltage gate-edge component                               | _     | 0       |
| STVBRGAT2  | Temp. co of breakdown voltage gate-edge component                               | _     | 0       |
| STVBRSTI1  | Temp. co of breakdown voltage STI-edge component                                | _     | 0       |
| STVBRSTI2  | Temp. co of breakdown voltage STI-edge component                                | _     | 0       |
| SUBVERSION | Model subversion  | _     | 0       |

Table 2-51. ADMS DIODE\_CMC Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| SWJUNEXP  | Flag for JUNCAP-express; 0=full model, 1=express model                | _     | 0       |
| TAU       | Carrier lifetime  | _     | 2e-07   |
| TAUT      | Temp. co of carrier lifetime  | _     | 0       |
| TEMPMAX   | maximum allowed junction temp   | _     | 155     |
| TEMPMIN   | minimum allowed junction temp   | _     | -55     |
| TNOM      | Alias reference temperature   | _     | 21      |
| TRJ       | Reference temperature   | _     | 21      |
| TT        | Transit time  | _     | 0       |
| TYPE      | Type parameter, in output value 1 reflects n-type, -1 reflects p-type | _     | 1       |
| VBIRBOT   | Built-in voltage at the reference temperature of bottom component     | _     | 1       |
| VBIRGAT   | Built-in voltage at the reference temperature of gate-edge component  | _     | 1       |
| VBIRSTI   | Built-in voltage at the reference temperature of STI-edge component   | -     | 1       |
| VBRBOT    | Breakdown voltage of bottom component                                 | _     | 10      |
| VBRGAT    | Breakdown voltage of gate-edge component                              | _     | 10      |
| VBRSTI    | Breakdown voltage of STI-edge component                               | _     | 10      |
| VERSION   | Model version   | _     | 2       |
| VFMAX     | maximum allowed forward junction bias                                 | _     | 0       |
| VJUNREF   | Typical maximum junction voltage; usually about 2*VSUP                | _     | 2.5     |
| VRMAX     | maximum allowed reverse junction bias                                 | _     | 0       |
| WI        | Length of drift region  | _     | 5e-06   |
| XJUNGAT   | Junction depth of gate-edge component                                 | _     | 1e-07   |
| XJUNSTI   | Junction depth of STI-edge component                                  | _     | 1e-07   |
| XTI       | Temp. co of saturation current  | _     | 3       |

Table 2-52. Diode level 2002 Output Variables

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| vak       | Voltage between anode and cathode excluding the series resistor | _     | none    |
| cj        | Total source junction capacitance                               | _     | none    |
| cjbot     | Junction capacitance (bottom component)                         | _     | none    |
| cjgat     | Junction capacitance (gate-edge component)                      | _     | none    |

Table 2-52. Diode level 2002 Output Variables

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| cjsti     | Junction capacitance (STI-edge component)            | _     | none    |
| ij        | Total source junction current                        | _     | none    |
| ijbot     | Junction current (bottom component)                  | _     | none    |
| ijgat     | Junction current (gate-edge component)               | _     | none    |
| ijsti     | Junction current (STI-edge component)                | -     | none    |
| si        | Total junction current noise spectral density        | _     | none    |
| vrs       | Voltage across series resistor                       | _     | none    |
| sf        | Total junction flicker noise spectral density        | _     | none    |
| sr        | Total series resistor thermal noise spectral density | -     | none    |
| rseries   | Series resistor                                      | _     | none    |
| qrr       | Recovery charge                                      | _     | none    |

## **Level 1 Diode Equations** The equations in this section use the following variables:

 $V_{di}$  = voltage across the intrinsic diode only

 $V_{th} = k \cdot T/q$  (thermal voltage)

k = Boltzmann's constant

q = electron charge

T = analysis temperature (Kelvin)

 $T_0$  = nominal temperature (set using **TNOM** option)

 $\omega$  = Frequency (Hz)

Other variables are listed above in the diode model parameters.

**Level=1** The level 1 diode is based on the Spice3f5 level 1 model.

**DC Current (Level=1)** The intrinsic diode current consists of forward and reverse bias regions where

$$I_D = \left\{ \begin{array}{l} \mathbf{IS} \cdot \left[ \exp\left(\frac{V_{di}}{\mathbf{N}V_{th}}\right) - 1 \right], & V_{di} > -3.0 \cdot \mathbf{N}V_{th} \\ -\mathbf{IS} \cdot \mathbf{tIRF} \cdot \left[ 1.0 + \left(\frac{3.0 \cdot \mathbf{N}V_{th}}{V_{di} \cdot e}\right)^3 \right], & V_{di} < -3.0 \cdot \mathbf{N}V_{th} \end{array} \right.$$

$$tIRF = \begin{cases} IRF \cdot (TEMP/TNOM)^{1.6}, & \text{if } IRF \text{ specified} \\ 1.0 & \text{if } IRF \text{ not specified} \end{cases}$$

**IRF** is a Xyce-specific parameter that can be used to scale the reverse-biased current to match measured data. It defaults to 1.0, which reduces the model to strict SPICE3F5 compatibility. **NOTE: The expressions involving IRF have not been validated, and use of IRF is deprecated. Setting IRF to any value may introduce non-physical solution discontinuities or simulation failures at higher** 

temperatures. This feature may be removed in a future release, and should not be used. Any setting of IRF in the model card (even setting it to the default of 1.0) will result in a warning from the diode device. Strict SPICE3F5 compatibility is only maintained by leaving this parameter out of any model cards for diodes.

When **BV** and an optional parameter **IBV** are explicitly given in the model statement, an exponential model is used to model reverse breakdown (with a "knee" current of **IBV** at a "knee-on" voltage of **BV**). The equation for  $I_D$  implemented by Xyce is given by

$$I_D = -\mathbf{IBV_{eff}} \cdot \exp\left(-\frac{\mathbf{BV_{eff}} + V_{di}}{\mathbf{N}V_{th}}\right), \qquad V_{di} \leq \mathbf{BV_{eff}},$$

where  $BV_{eff}$  and  $IBV_{eff}$  are chosen to satisfy the following constraints:

1. Continuity of  $I_D$  between reverse bias and reverse breakdown regions (i.e., continuity of  $I_D$  at  $V_{di} = -\mathbf{B}\mathbf{V}_{\mathbf{eff}}$ ):

$$\mathbf{IBV_{eff}} = \mathbf{IRF} \cdot \mathbf{IS} \left( 1 - \left( \frac{3.0 \cdot \mathbf{N}V_{th}}{e \cdot \mathbf{BV_{eff}}} \right)^{3} \right)$$

2. "Knee-on" voltage/current matching:

$$\mathbf{IBV_{eff}} \cdot \exp\left(-\frac{\mathbf{BV_{eff}} - \mathbf{BV}}{\mathbf{N}V_{th}}\right) = \mathbf{IBV}$$

Substituting the first expression into the second yields a single constraint on  $BV_{eff}$  which cannot be solved for directly. By performing some basic algebraic manipulation and rearranging terms, the problem of finding  $BV_{eff}$  which satisfies the above two constraints can be cast as finding the (unique) solution of the equation

$$\mathbf{BV_{eff}} = f(\mathbf{BV_{eff}}),\tag{2.22}$$

where  $f(\cdot)$  is the function that is obtained by solving for the  $\mathbf{BV_{eff}}$  term which appears in the exponential in terms of  $\mathbf{BV_{eff}}$  and the other parameters. Xyce solves Eqn. 2.22 by performing the so-called *Picard Iteration* procedure [12], i.e. by producing successive estimates of  $\mathbf{BV_{eff}}$  (which we will denote as  $\mathbf{BV_{eff}}^k$ ) according to

$$\mathbf{BV_{eff}}^{k+1} = f(\mathbf{BV_{eff}}^k)$$

starting with an initial guess of  $\mathbf{BV_{eff}}^0 = \mathbf{BV}$ . The current iteration procedure implemented in Xyce can be shown to guarantee at least six significant digits of accuracy between the numerical estimate of  $\mathbf{BV_{eff}}$  and the true value.

In addition to the above, Xyce also requires that  $\mathbf{BV_{eff}}$  lie in the range  $\mathbf{BV} \ge \mathbf{BV_{eff}} \ge 3.0 \mathbf{N}V_{th}$ . In terms of  $\mathbf{IBV}$ , this is equivalent to enforcing the following two constraints:

$$\mathbf{IRF} \cdot \mathbf{IS} \left( 1 - \left( \frac{3.0 \cdot \mathbf{N} V_{th}}{e \cdot \mathbf{BV}} \right)^3 \right) \leq \mathbf{IBV}$$
 (2.23)

$$\mathbf{IRF} \cdot \mathbf{IS} \left( 1 - e^{-3} \right) \exp \left( \frac{-3.0 \cdot \mathbf{N} V_{th} + \mathbf{BV}}{\mathbf{N} V_{th}} \right) \geq \mathbf{IBV}$$
 (2.24)

Xyce first checks the value of **IBV** to ensure that the above two constraints are satisfied. If Eqn. 2.23 is violated, Xyce sets  $\mathbf{IBV_{eff}}$  to be equal to the left-hand side of Eqn. 2.23 and, correspondingly, sets  $\mathbf{BV_{eff}}$  to  $-3.0 \cdot \mathbf{NV_{th}}$ . If Eqn. 2.24 is violated, Xyce sets  $\mathbf{IBV_{eff}}$  to be equal to the left-hand side of Eqn. 2.24 and, correspondingly, sets  $\mathbf{BV_{eff}}$  to  $\mathbf{BV}$ .

**Capacitance (Level=1)** The p-n diode capacitance consists of a depletion layer capacitance  $C_d$  and a diffusion capacitance  $C_{dif}$ . The first is given by

$$C_{d} = \begin{cases} \mathbf{CJ} \cdot \mathbf{AREA} \left( 1 - \frac{V_{di}}{\mathbf{VJ}} \right)^{-\mathbf{M}}, & V_{di} \leq \mathbf{FC} \cdot \mathbf{VJ} \\ \frac{\mathbf{CJ} \cdot \mathbf{AREA}}{\mathbf{F2}} \left( \mathbf{F3} + \mathbf{M} \frac{V_{di}}{\mathbf{VJ}} \right), & V_{di} > \mathbf{FC} \cdot \mathbf{VJ} \end{cases}$$

The diffusion capacitance (sometimes referred to as the transit time capacitance) is

$$C_{dif} = \mathbf{TT}G_d = \mathbf{TT}\frac{dI_D}{dV_{di}}$$

where  $G_d$  is the junction conductance.

**Temperature Effects (Level=1)** The diode model contains explicit temperature dependencies in the ideal diode current, the generation/recombination current and the breakdown current. Further temperature dependencies are present in the diode model via the saturation current  $I_S$ , the depletion layer junction capacitance CJ, the junction potential  $V_J$ .

$$V_{tnom}(T) = \frac{kT}{q}$$

$$V_{tnom}(T) = \frac{kTNOM}{q}$$

$$E_g(T) = E_{g0} - \frac{\alpha T^2}{\beta + T}$$

$$E_{gNOM}(T) = E_{g0} - \frac{\alpha TNOM^2}{TNOM + \beta}$$

$$arg1(T) = -\frac{E_g(T)}{2kT} + \frac{E_{g300}}{2kT_{0}}$$

$$arg2(T) = -\frac{E_{gNOM}(T)}{2kTNOM} + \frac{E_{g300}}{2kT_{0}}$$

$$pbfact1(T) = -2.0 \cdot V_t(T) \left(1.5 \cdot \ln\left(\frac{T}{T_0}\right) + q \cdot arg1(T)\right)$$

$$pbfact2(T) = -2.0 \cdot V_{tnom}(T) \left(1.5 \cdot \ln\left(\frac{TNOM}{T_0}\right) + q \cdot arg2(T)\right)$$

$$pbo(T) = (\mathbf{VJ} - pbfact2(T)) \frac{T_0}{TNOM}$$

$$V_J(T) = pbfact1(T) + \frac{T}{T_0}pbo(T)$$

$$gma_{old}(T) = \frac{\mathbf{VJ} - pbo(T)}{pbo(T)}$$

$$gma_{new}(T) = \frac{\mathbf{VJ} - pbo(T)}{pbo(T)}$$

$$CJ(T) = \mathbf{CJ0} \frac{1.0 + \mathbf{M}(4.0 \times 10^{-4}(T - T_0) - gma_{new}(T))}{1.0 + \mathbf{M}(4.0 \times 10^{-4}(TNOM - T_0) - gma_{old}(T))}$$

$$I_S(T) = \mathbf{IS} \cdot \exp\left(\left(\frac{T}{TNOM} - 1.0\right) \cdot \frac{\mathbf{EG}}{NV_I(T)} + \frac{\mathbf{XTI}}{N} \cdot \ln\left(\frac{T}{TNOM}\right)\right)$$

where, for silicon,  $\alpha = 7.02 \times 10^{-4} \ eV/K$ ,  $\beta = 1108 \ K$  and  $E_{g0} = 1.16 \ eV$ .

For a more thorough description of p-n junction physics, see [9]. For a thorough description of the U.C. Berkeley SPICE models see Reference [11].

## 2.3.9. Independent Current Source



## **Symbol**

## Examples ISLOW 1 22 SIN(0.5 1.0ma 1KHz 1ms)

IPULSE 1 3 PULSE(-1 1 2ns 2ns 2ns 50ns 100ns)
IPAT 2 4 PAT(5 0 0 1n 2n 5n b0101)

## Parameters and Options

### transient specification

There are five predefined time-varying functions for sources:

PULSE <parameters> Pulse waveform

SIN <parameters> Sinusoidal waveform

EXP <parameters> Exponential waveform

PAT <parameters> Pattern waveform

PWL <parameters> Piecewise linear waveform

SFFM <parameters> Frequency-modulated waveform

#### **Comments**

Positive current flows from the positive node through the source to the negative node.

The power supplied or dissipated by the current source is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

The default value is zero for the DC, AC, and transient values. None, any, or all of the DC, AC, and transient values can be specified. The AC phase value is in degrees.

**Transient Specifications** This section outlines the available transient specifications.  $\Delta t$  and  $T_F$  are the time step size and simulation end-time, respectively. Parameters marked as – must have a value specified for them; otherwise a netlist parsing error will occur.

#### **Pulse**

PULSE (V1 V2 TD TR TF PW PER)

Table 2-53. Pulse Parameters

| Parameter | Description   | Units | Default    |
|-----------|---------------|-------|------------|
| V1        | Initial Value | amp   | _          |
| V2        | Pulse Value   | amp   | 0.0        |
| TD        | Delay Time    | S     | 0.0        |
| TR        | Rise Time     | S     | $\Delta t$ |
| TF        | Fall Time     | S     | $\Delta t$ |
| PW        | Pulse Width   | S     | $T_F$      |
| PER       | Period        | S     | $T_F$      |

## Sine

SIN (VO VA FREQ TD THETA PHASE)

**Table 2-54. Sine Parameters** 

| Parameter | Description        | Units    | Default    |
|-----------|--------------------|----------|------------|
| VO        | Offset             | amp      | _          |
| VA        | Amplitude          | amp      | _          |
| FREQ      | Frequency          | $s^{-1}$ | _          |
| TD        | Delay              | S        | $\Delta t$ |
| THETA     | Attenuation Factor | S        | $\Delta t$ |
| PHASE     | Phase              | degrees  | 0.0        |

The waveform is shaped according to the following equations, where  $\phi = \pi * PHASE/180$ :

$$I = \begin{cases} V_0, & 0 < t < T_D \\ V_0 + V_A \sin[2\pi \cdot \mathbf{FREQ} \cdot (t - T_D) + \phi] \exp[-(t - T_D) \cdot \mathbf{THETA}], & T_D < t < T_F \end{cases}$$

## **Exponent**

EXP (V1 V2 TD1 TAU1 TD2 TAU2)

**Table 2-55. Exponent Parameters** 

| Parameter | Description        | Units | Default    |
|-----------|--------------------|-------|------------|
| V1        | Initial Amplitude  | amp   | _          |
| V2        | Amplitude          | amp   | _          |
| TD1       | Rise Delay Time    | S     | 0.0        |
| TAU1      | Rise Time Constant | S     | $\Delta t$ |

Table 2-55. Exponent Parameters

| Parameter | Description        | Units | Default         |
|-----------|--------------------|-------|-----------------|
| TD2       | Delay Fall Time    | S     | TD1 $+\Delta t$ |
| TAU2      | Fall Time Constant | S     | $\Delta t$      |

The waveform is shaped according to the following equations:

$$I = \begin{cases} V_1, & 0 < t < \text{TD1} \\ V_1 + (V_2 - V_1)\{1 - \exp[-(t - \text{TD1})/\text{TAU1}]\}, & \text{TD1} < t < \text{TD2} \\ V_1 + (V_2 - V_1)\{1 - \exp[-(t - \text{TD1})/\text{TAU1}]\} \\ + (V_1 - V_2)\{1 - \exp[-(t - \text{TD2})/\text{TAU2}]\}, & \text{TD2} < t < T_2 \end{cases}$$

#### **Pattern**

PAT (VHI VLO TD TR TF TSAMPLE DATA R)

Table 2-56. Pattern Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| VHI       | High Value  | amp   | _       |
| VLO       | Low Value   | amp   | _       |
| TD        | Delay Time  | S     | _       |
| TR        | Rise Time   | S     | _       |
| TF        | Fall Time   | S     | _       |
| TSAMPLE   | Bit period  | S     | _       |
| DATA      | Bit pattern | _     | _       |
| R         | Repeat      | _     | 0       |

The VHI, VLO, TD, TF, TF TSAMPLE and DATA parameters are all required, and hence have no default values. Negative values for TD are supported. The R parameter is optional. For its default value of 0, the requested bit pattern will occur once.

The DATA parameter is the requested bit-pattern. Only the 0' and '1' states are supported. The 'M' and 'Z' states are not supported. The DATA field should have a leading 'b' (or 'B') character (e.g., be specified as 'b0101').

For times earlier than TD, the waveform value is set by the first bit in DATA. For times after the end of the (possibly repeated) pattern, the waveform value is set by the last bit in DATA. Piecewise linear interpolation is used to generate the output value when transitioning between states.

The VHI, VLO, TD, TF, TF and TSAMPLE parameters are compatible with . STEP. The DATA and R parameters are not.

The HSPICE parameters RB, ENCODE and RD\_INIT, for the pattern source, are not supported.

#### **Piecewise Linear**

```
PWL T0 V0 [Tn Vn]*
PWL FILE "<name>" [TD=<timeDelay>] [R=<repeatTime>]
```

Table 2-57. Piecewise Linear Parameters

| Parameter | Description       | Units | Default |
|-----------|-------------------|-------|---------|
| $T_n$     | Time at Corner    | S     | none    |
| $V_n$     | Current at Corner | amp   | none    |
| TD        | Time Delay        | S     | 0       |
| R         | Repeat Time       | S     | none    |

When the FILE option is given, Xyce will read the corner points from the file specified in the <name> field. This file should be a plain ASCII text file (or a .CSV file) with the time/current pairs. There should be one pair per line, and the time and current values should be separated by whitespace or commas. As an example, the file specified (e.g., ipwl.csv) could have these five lines:

```
0.00, 0.00
2.00, 3.00
3.00, 2.00
4.00, 2.00
4.01, 5.00
```

The corresponding example instance lines would be:

```
IPWL1 1 0 PWL 0S 0A 2S 3A 3S 2A 4S 2A 4.01S 5A IPWL2 2 0 PWL FILE "ipwl.txt"
IPWL3 3 0 PWL file "ipwl.csv"
IPWL4 4 0 PWL FILE ipwl.csv
```

The double quotes around the file name are optional, as shown above.

It is a best practice to specify all of the time-current pairs in the PWL specification. However, for compatibility with HSPICE and PSpice, if the user-specified list of time/current pairs omits the pair at time=0 as the first pair in the list then Xyce will insert a pair at time=0 with the current value at the first user-specified time value. As an example, this user-specified list:

```
2S 3A 3S 2A 4S 2A 4.01S 5A
```

would be implemented in Xyce as follows:

```
OS 3A 2S 3A 3S 2A 4S 2A 4.01S 5A
```

TD has units of seconds, and specifies the length of time to delay the start of PWL waveform. The default is to have no delay, and TD is an optional parameter.

The Repeat Time (R) is an optional parameter. If R is omitted then the waveform will not repeat. If R is included then the waveform will repeat until the end of the simulation. As examples, R=0 means repeat the PWL waveform from time=0 to the last time  $(T_N)$  specified in the waveform specification. (This would use the time points 0s, 2s, 3s, 4s and 4.01s for the example waveform given above.). In general, R=<repeatTime> means repeat the waveform from time equal to <repeatTime> seconds in the waveform specification to the last time  $(T_N)$  specified in the waveform specification. So, the <repeatTime> must be greater than or equal to 0 and less than the last time point  $(T_N)$ . If the R parameter is used then it must have a value.

The specification PWL FILE "<name>" R is illegal in Xyce as a shorthand for R=0. Also, the Xyce syntax for PWL sources is not compatible with the PSpice REPEAT syntax for PWL sources. See section 6.1.12 for more details.

The repeat time (R) does enable the specification of discontinuous piecewise linear waveforms. For example, this waveform is a legal Xyce syntax.

However, in general, discontinuous source waveforms may cause convergence problems.

## **Frequency Modulated**

SFFM (V0 VA FC MDI FS)

**Table 2-58. Frequency Modulated Parameters** 

| Parameter | Description       | Units | Default         |
|-----------|-------------------|-------|-----------------|
| V0        | Offset            | amp   | _               |
| VA        | Amplitude         | amp   | _               |
| FC        | Carrier Frequency | hertz | 1/TSTOP         |
| MDI       | Modulation Index  | -     | 0               |
| FS        | Signal Frequency  | hertz | 1/ <b>TSTOP</b> |

TSTOP is the final time, as entered into the transient (.TRANS) command. The waveform is shaped according to the following equation:

$$I = V_0 + V_A \cdot \sin(2\pi \cdot FC \cdot TIME + MDI \cdot \sin(2\pi \cdot FS \cdot TIME))$$

where **TIME** is the current simulation time.

## 2.3.10. Independent Voltage Source



## **Symbol**

## Examples VSLOW 1 22 SIN(0.5 1.0mV 1KHz 1ms)

VPULSE 1 3 PULSE(-1 1 2ns 2ns 2ns 50ns 100ns) VPAT 2 4 PAT(5 0 0 1n 2n 5n b0101)

# Parameters and Options

#### transient specification

There are five predefined time-varying functions for sources:

PULSE <parameters> Pulse waveform
SIN <parameters> Sinusoidal waveform
EXP <parameters> Exponential waveform
PAT <parameters> Pattern waveform

PWL <parameters> Piecewise linear waveform

SFFM <parameters> Frequency-modulated waveform

## **Comments**

Positive current flows from the positive node through the source to the negative node.

The power supplied or dissipated by the voltage source is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

None, any, or all of the DC, AC, and transient values can be specified. The AC phase value is in degrees.

**Transient Specifications** This section outlines the available transient specifications.  $\Delta t$  and  $T_F$  are the time step size and simulation end-time, respectively. Parameters marked as – must have a value specified for them; otherwise a netlist parsing error will occur.

#### **Pulse**

PULSE (V1 V2 TD TR TF PW PER)

Table 2-59. Pulse Parameters

| Parameter | Description   | Units | Default    |
|-----------|---------------|-------|------------|
| V1        | Initial Value | Volt  | _          |
| V2        | Pulse Value   | Volt  | 0.0        |
| TD        | Delay Time    | S     | 0.0        |
| TR        | Rise Time     | S     | $\Delta t$ |
| TF        | Fall Time     | S     | $\Delta t$ |
| PW        | Pulse Width   | S     | $T_F$      |
| PER       | Period        | S     | $T_F$      |

## Sine

SIN (VO VA FREQ TD THETA PHASE)

**Table 2-60. Sine Parameters** 

| Parameter | Description        | Units    | Default    |
|-----------|--------------------|----------|------------|
| V0        | Offset             | Volt     | _          |
| VA        | Amplitude          | Volt     | _          |
| FREQ      | Frequency          | $s^{-1}$ | _          |
| TD        | Delay              | S        | $\Delta t$ |
| THETA     | Attenuation Factor | S        | $\Delta t$ |
| PHASE     | Phase              | degrees  | 0.0        |

The waveform is shaped according to the following equations, where  $\phi = \pi * PHASE/180$ :

$$V = \begin{cases} V_0, & 0 < t < T_D \\ V_0 + V_A \sin[2\pi \cdot \mathbf{FREQ} \cdot (t - T_D) + \phi] \exp[-(t - T_D) \cdot \mathbf{THETA}], & T_D < t < T_F \end{cases}$$

## **Exponent**

EXP (V1 V2 TD1 TAU1 TD2 TAU2)

**Table 2-61. Exponent Parameters** 

| Parameter | Description        | Units | Default    |
|-----------|--------------------|-------|------------|
| V1        | Initial Amplitude  | Volt  | _          |
| V2        | Amplitude          | Volt  | _          |
| TD1       | Rise Delay Time    | S     | 0.0        |
| TAU1      | Rise Time Constant | S     | $\Delta t$ |

Table 2-61. Exponent Parameters

| Parameter | Description        | Units | Default          |
|-----------|--------------------|-------|------------------|
| TD2       | Delay Fall Time    | S     | $TD1 + \Delta t$ |
| TAU2      | Fall Time Constant | S     | $\Delta t$       |

The waveform is shaped according to the following equations:

$$V = \begin{cases} V_1, & 0 < t < \text{TD1} \\ V_1 + (V_2 - V_1)\{1 - \exp[-(t - \text{TD1})/\text{TAU1}]\}, & \text{TD1} < t < \text{TD2} \\ V_1 + (V_2 - V_1)\{1 - \exp[-(t - \text{TD1})/\text{TAU1}]\} \\ + (V_1 - V_2)\{1 - \exp[-(t - \text{TD2})/\text{TAU2}]\}, & \text{TD2} < t < T_2 \end{cases}$$

#### **Pattern**

PAT (VHI VLO TD TR TF TSAMPLE DATA R)

**Table 2-62. Pattern Parameters** 

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| VHI       | High Value  | Volt  | _       |
| VLO       | Low Value   | Volt  | _       |
| TD        | Delay Time  | S     | _       |
| TR        | Rise Time   | S     | _       |
| TF        | Fall Time   | S     | _       |
| TSAMPLE   | Bit period  | S     | _       |
| DATA      | Bit pattern | _     | _       |
| R         | Repeat      | _     | 0       |

The VHI, VLO, TD, TF, TF TSAMPLE and DATA parameters are all required, and hence have no default values. Negative values for TD are supported. The R parameter is optional. For its default value of 0, the requested bit pattern will occur once.

The DATA parameter is the requested bit-pattern. Only the 0' and '1' states are supported. The 'M' and 'Z' states are not supported. The DATA field should have a leading 'b' (or 'B') character (e.g., be specified as 'b0101').

For times earlier than TD, the waveform value is set by the first bit in DATA. For times after the end of the (possibly repeated) pattern, the waveform value is set by the last bit in DATA. Piecewise linear interpolation is used to generate the output value when transitioning between states.

The relationship between the various source parameters can be illustrated with the following example:

V1 1 0 PAT(5 0 0 1n 1n 5n b010)

That V1 source definition would produce time-voltages pairs at  $(0\ 0)\ (4.5\text{ns}\ 0)\ (5\text{ns}\ 2.5)\ (5.5\text{ns}\ 5.0)\ (9.5\text{ns}\ 5.0)\ (10\text{ns}\ 2.5)\ (10.5\text{ns}\ 0)$ . So, the bit period is 5ns and the voltage value at the start/end of each "sample" is equal to 0.5\*(VHI + VLO). The first rise is centered around t=5ns, and hence starts at t=4.5ns and ends at t=5.5 ns.

The VHI, VLO, TD, TF, TF and TSAMPLE parameters are compatible with . STEP. The DATA and R parameters are not.

The HSPICE parameters RB, ENCODE and RD\_INIT, for the pattern source, are not supported.

## **Piecewise Linear**

```
PWL T0 V0 [Tn Vn]*
PWL FILE "<name>" [TD=<timeDelay>] [R=<repeatTime>]
```

**Table 2-63. Piecewise Linear Parameters** 

| Parameter  | Description       | Units | Default |
|------------|-------------------|-------|---------|
| $T_n$      | Time at Corner    | S     | none    |
| $\nabla_n$ | Voltage at Corner | Volt  | none    |
| TD         | Time Delay        | S     | 0       |
| R          | Repeat Time       | S     | none    |

When the FILE option is given, Xyce will read the corner points from the file specified in the <name> field. This file should be a plain ASCII text file (or a .CSV file) with time/voltage pairs. There should be one pair per line, and the time and voltage values should be separated by whitespace or commas. As an example, the file specified (e.g., vpwl.csv) could have these five lines:

```
0.00, 0.00
2.00, 3.00
3.00, 2.00
4.00, 2.00
4.01, 5.00
```

The corresponding example instance lines would be:

```
VPWL1 1 0 PWL 0S 0V 2S 3V 3S 2V 4S 2V 4.01S 5V VPWL2 2 0 PWL FILE "vpwl.txt"
VPWL3 3 0 PWL file "vpwl.csv"
VPWL4 4 0 PWL FILE vpwl.csv
```

The double quotes around the file name are optional, as shown above.

It is a best practice to specify all of the time-voltage pairs in the PWL specification. However, for compatibility with HSPICE and PSpice, if the user-specified list of time/voltage pairs omits the pair at time=0 as the first pair in the list then Xyce will insert a pair at time=0 with the voltage value at the first user-specified time value. As an example, this user-specified list:

2S 3V 3S 2V 4S 2V 4.01S 5V

would be implemented in Xyce as follows:

```
OS 3V 2S 3V 3S 2V 4S 2V 4.01S 5V
```

TD has units of seconds, and specifies the length of time to delay the start of PWL waveform. The default is to have no delay, and TD is an optional parameter.

The Repeat Time (R) is an optional parameter. If R is omitted then the waveform will not repeat. If R is included then the waveform will repeat until the end of the simulation. As examples, R=0 means repeat the PWL waveform from time=0 to the last time  $(T_N)$  specified in the waveform specification. (This would use the time points 0s, 2s, 3s, 4s and 4.01s for the example waveform given above.) In general, R=<repeatTime> means repeat the waveform from time equal to <repeatTime> seconds in the waveform specification to the last time  $(T_N)$  specified in the waveform specification. So, the <repeatTime> must be greater than or equal to 0 and less than the last time point  $(T_N)$ . If the R parameter is used then it must have a value.

The specification PWL FILE "<name>" R is illegal in Xyce as a shorthand for R=0. Also, the Xyce syntax for PWL sources is not compatible with the PSpice REPEAT syntax for PWL sources. See section 6.1.12 for more details.

The repeat time (R) does enable the specification of discontinuous piecewise linear waveforms. For example, this waveform is a legal Xyce syntax.

However, in general, discontinuous source waveforms may cause convergence problems.

## **Frequency Modulated**

SFFM (V0 VA FC MDI FS)

**Table 2-64. Frequency Modulated Parameters** 

| Parameter | Description       | Units | Default |
|-----------|-------------------|-------|---------|
| V0        | Offset            | Volt  | _       |
| VA        | Amplitude         | Volt  | _       |
| FC        | Carrier Frequency | hertz | 1/TSTOP |
| MDI       | Modulation Index  | -     | 0       |
| FS        | Signal Frequency  | hertz | 1/TSTOP |

**TSTOP** is the final time, as entered into the transient (.TRANS) command. The waveform is shaped according to the following equation:

$$V = V_0 + V_A \cdot \sin(2\pi \cdot FC \cdot TIME + MDI \cdot \sin(2\pi \cdot FS \cdot TIME))$$

where **TIME** is the current simulation time.

### 2.3.11. Port Device

#### **Instance Form**

```
P<name> <(+) node> <(-) node> [[DC] <value> ] port=port number
+ [Z0 = value] [AC [magnitude value [phase value] ] ]
+ [transient specification]
```

#### **Examples**

```
P1 1 0 port = 1
P2 12 0 port=1 z0=100
P1 1 0 port=2 sin 0 1 1e5
P2 2 0 port=2 z0=100 AC 1
```

# Parameters and Options

#### port

The port number. Numbered sequentially beginning with 1

**Z0** System impedance. Currently, it only supports a real-valued impedance.

## transient specification

There are six predefined time-varying functions for sources:

```
PULSE <parameters> Pulse waveform

SIN <parameters> Sinusoidal waveform

EXP <parameters> Exponential waveform

PAT <parameters> Pattern waveform

PWL <parameters> Piecewise linear waveform

SFFM <parameters> Frequency-modulated waveform
```

#### Comments

The port device identifies the ports used in .LIN analysis. Each port requires a unique port number. For example, if the netlist has N port devices, it must contain the sequential set of port numbers, from 1 to N. Each port has an associated impedance Z0. The default is 50 ohms.

The port device behaves as a voltage source in series with an impedance for all other analyses, such as DC, AC and transient.

None, any, or all of the DC, AC, and transient values can be specified. The AC phase value is in degrees. The port device accepts the same transient specifications as the voltage (V) sources.

Positive current flows from the positive node through the port device to the negative node.

The power supplied or dissipated by the port device is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

## 2.3.12. Voltage Controlled Voltage Source



## **Symbol**

#### **Instance Form**

```
E<name> <(+) node> <(-) node> <(+) controlling node>
+ <(-) controlling node> <gain>
E<name> <(+) node> <(-) node> VALUE = { <expression> }
+ [device parameters]
E<name> <(+) node> <(-) node> TABLE { <expression> } =
+ < <input value>, <output value> >*
E<name> <(+) node> <(-) node> POLY(<value>)
+ [<+ control node> <- control node>]*
+ [<polynomial coefficient value>]*
```

## **Examples**

```
EBUFFER 1 2 10 11 5.0

ESQROOT 5 0 VALUE = {5V*SQRT(V(3,2))}

ET2 2 0 TABLE {V(ANODE, CATHODE)} = (0,0) (30,1)

EP1 5 1 POLY(2) 3 0 4 0 0 .5 .5
```

## Parameters and Options

- (+) node
- (-) node

Output nodes. Positive current flows from the (+) node through the source to the (-) node.

- (+) controlling node
- (-) controlling node

Node pairs that define a set of controlling voltages. A given node may appear multiple times and the output and controlling nodes may be the same.

#### device parameters

The second form supports two instance parameters smoothbsrc and rcconst. Parameters may be provided as space separated <parameter>=<value> specifications as needed. The default value for smoothbsrc is 0 and the default for rcconst is 1e-9.

#### **Comments**

In the first form, a specified voltage drop between controlling nodes is multiplied by the gain to determine the voltage drop across the output nodes.

The second through fourth forms allow nonlinear controlled sources using the VALUE, TABLE, or POLY keywords, respectively, and are used in analog behavioral modeling. They are provided primarily for netlist compatibility with other simulators. These three forms are automatically converted within Xyce to its principal ABM device, the B nonlinear dependent source device. See the B-source section (2.3.16) and the Xyce User's Guide for more guidance on analog behavioral modeling. For details concerning the use of the POLY format, see section 2.2.5.

For HSPICE compatibility, VOL is an allowed synonym for VALUE for the E-source.

The power supplied or dissipated by this source device is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

**NOTE:** The expression given on the left hand side of the equals sign in E source TABLE expressions may be enclosed in braces, but is not required to be. Further, if braces are present there must be exactly one pair of braces and it must enclose the entire expression. It is not legal to use additional pairs of braces as parentheses inside these expressions. So

```
ET2 2 0 TABLE {V(ANODE, CATHODE) +5} = (0,0) (30,1)

ET3 2 0 TABLE V(ANODE, CATHODE) +5 = (0,0) (30,1)

are legal, but

ET2 2 0 TABLE {V(ANODE, CATHODE) + {5}} = (0,0) (30,1)
```

is not. This last will result in a parsing error about missing braces.

E-sources were originally developed primarily to support DC and transient analysis. As such, their support for frequency domain analysis (AC and HB) has some limitations. The main limitation to be aware of is that time-dependent sources will not work with AC or HB analysis. These are sources in which the variable TIME is used in the VALUE= expression. However, this time-dependent usage is not common. The most common use case is one in which the E-source is purely dependent (depends only on other solution variables), and this use case will work with AC and HB.

## 2.3.13. Current Controlled Current Source



## **Symbol**

## **Instance Form**

F<name> <(+) node> <(-) node>

+ <controlling V device name> <gain>

F<name> <(+) node> <(-) node> POLY(<value>)

+ <controlling V device name>\*

+ < <polynomial coefficient value> >\*

## **Examples**

FSENSE 1 2 VSENSE 10.0

FAMP 13 0 POLY(1) VIN 0 500

FNONLIN 100 101 POLY(2) VCNTRL1 VCINTRL2 0.0 13.6 0.2 0.005

## Parameters and Options

#### (+) node

#### (-) node

Output nodes. Positive current flows from the (+) node through the source to the (-) node.

## controlling V device

The controlling voltage source which must be an independent voltage source (V device).

## **Comments**

In the first form, a specified current through a controlling device is multiplied by the gain to determine this device's output current. The gain may be expressed either as a number, a parameter, or an arbitrary brace-delimited ABM expression.

The second form using the POLY keyword is used in analog behavioral modeling.

Both forms are automatically converted within Xyce to its principal ABM device, the B nonlinear dependent source device. See the B-source section (2.3.16) and the Xyce User's Guide for more guidance on analog behavioral modeling. For details concerning the use of the POLY format, see section 2.2.5.

The power supplied or dissipated by this source device is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

F-sources were originally developed primarily to support DC and transient analysis. As such, their support for frequency domain analysis (AC and HB) has some limitations. The main limitation to be aware of is that time-dependent sources will not work with AC or HB analysis. These are sources in which the variable TIME is used in the VALUE= expression. However, this time-dependent usage is not common. The most common use case is one in which the F-source is purely dependent (depends only on other solution variables), and this use case will work with AC and HB.

## 2.3.14. Voltage Controlled Current Source



#### **Symbol**

#### **Instance Form**

```
G<name> <(+) node> <(-) node> <(+) controlling node>
+ <(-) controlling node> <transconductance>
G<name> <(+) <node> <(-) node> VALUE = { <expression> }
G<name> <(+) <node> <(-) node> TABLE { <expression> } =
+ < <input value>,<output value> >*
G<name> <(+) <node> <(-) node> POLY(<value>)
+ [<+ controlling node> <- controlling node>]*
+ [<polynomial coefficient>]*
```

## **Examples**

```
GBUFFER 1 2 10 11 5.0

GPSK 11 6 VALUE = {5MA*SIN(6.28*10kHz*TIME+V(3))}

GA2 2 0 TABLE {V(5)} = (0,0) (1,5) (10,5) (11,0)
```

# Parameters and Options

- (+) node
- (-) node

Output nodes. Positive current flows from the (+) node through the source to the (-) node.

- (+) controlling node
- (-) controlling node

Node pairs that define a set of controlling voltages. A given node may appear multiple times and the output and controlling nodes may be the same.

#### **Comments**

In the first form, the voltage drop between the controlling nodes is multiplied by the transconductance to obtain the current-source output of the G device.

The second through fourth forms using the VALUE, TABLE, and POLY keywords, respectively, are used in analog behavioral modeling. They are provided primarily for netlist compatibility with other simulators. These two forms are automatically converted within Xyce to its principal ABM device, the B nonlinear dependent source device. See the B-source section (2.3.16) and the Xyce User's Guide for more guidance on analog behavioral modeling. For details concerning the use of the POLY format, see section 2.2.5.

For HSPICE compatibility, CUR is an allowed synonym for VALUE for the G-source.

The power supplied or dissipated by this source device is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

**NOTE:** The expression given on the left hand side of the equals sign in G source TABLE expressions may be enclosed in braces, but is not required to be. Further, if braces are present there must be exactly one pair of braces and it must enclose the entire expression. It is not legal to use additional pairs of braces as parentheses inside these expressions. So

```
GA2 2 0 TABLE \{V(5)+5\} = (0,0) (1,5) (10,5) (11,0)

GA3 2 0 TABLE V(5) = (0,0) (1,5) (10,5) (11,0)

are legal, but

GA2 2 0 TABLE \{V(5)+\{5\}\} = (0,0) (1,5) (10,5) (11,0)
```

is not. This last will result in a parsing error.

G-sources were originally developed primarily to support DC and transient analysis. As such, their support for frequency domain analysis (AC and HB) has some limitations. The main limitation to be aware of is that time-dependent sources will not work with AC or HB analysis. These are sources in which the variable TIME is used in the VALUE= expression. However, this time-dependent usage is not common. The most common use case is one in which the G-source is purely dependent (depends only on other solution variables), and this use case will work with AC and HB.

## 2.3.15. Current Controlled Voltage Source

The syntax of this device is exactly the same as for a Current-Controlled Current Source. For a Current-Controlled Voltage Source just substitute an H for the F. The H device generates a voltage, whereas the F device generates a current.



## **Symbol**

#### **Instance Form**

H<name> <(+) node> <(-) node>
+ <controlling V device name> <transresistance>
H<name> <(+) node> <(-) node> POLY(<value>)
+ <controlling V device name>\*

+ < <polynomial coefficient value> >\*

## **Examples**

HSENSE 1 2 VSENSE 10.0 HAMP 13 0 POLY(1) VIN 0 500 HNONLIN 100 101 POLY(2) VCNTRL1 VCINTRL2 0.0 13.6 0.2 0.005

#### **Comments**

In the first form, the current through a specified controlling voltage source is multiplied by the transresistance to obtain the voltage-source output. The transresistance may be expressed either as a number, a parameter, or an arbitrary brace-delimited ABM expression.

The second form using the POLY keyword is used in analog behavioral modeling. It is provided primarily for netlist compatibility with other simulators.

H sources in any form are automatically converted within Xyce to its principal ABM device, the B nonlinear dependent source device. See the B-source section (2.3.16) and the Xyce User's Guide for more guidance on analog behavioral modeling. For details concerning the use of the POLY format, see section 2.2.5.

The power supplied or dissipated by this source device is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

H-sources were originally developed primarily to support DC and transient analysis. As such, their support for frequency domain analysis (AC and HB) has some limitations. The main limitation to be aware of is that time-dependent sources will not work with AC or HB analysis. These are sources in which the variable TIME is used in the VALUE= expression. However, this time-dependent usage is not common. The most common use case is one in which the H-source is purely dependent (depends only on other solution variables), and this use case will work with AC and HB.

## 2.3.16. Nonlinear Dependent Source

### **Examples**

```
B1 2 0 V={sqrt(V(1))}
B2 4 0 V={V(1)*TIME}
B3 4 2 I={I(V1) + V(4,2)/100}
B4 5 0 V={Table {V(5)}=(0,0) (1.0,2.0) (2.0,3.0) (3.0,10.0)}
B5 6 0 V=tablefile("file.dat")
B6 7 0 I=tablefile("file.dat")
B6 7 0 I=table("file.dat")
B6 7 0 V={table("file.dat")}
B6 7 0 V={table("file.dat")}
B7 0 V={table("file.dat")}
B8 6 0 V={table("file.dat")}
B9 6 0 V={spline("file.dat")}
B9 6 0 V={fasttable("file.dat")}
```

#### **Comments**

The nonlinear dependent source device, also known as the B-source device, is used in analog behavioral modeling (ABM). The (+) and (-) nodes are the output nodes. Positive current flows from the (+) node through the source to the (-) node.

The power supplied or dissipated by the nonlinear dependent source is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . Dissipated power has a positive sign, while supplied power has a negative sign.

The syntax involving the tablefile keyword internally attempts to load the data in "file.dat" into a TABLE expression. The data file must be in plain-text and contain just two pairs of data per line. For an example see the "Analog Behavioral Modeling" chapter of the Xyce User's Guide. Either table or tablefile can be used to read a table in from a file. They are synonyms.

Other related table-based features include fasttable, which is the same as table but without many breakpoints, and bli for Barycentric Lagrange Interpolation [11]. Various splines are also supported, including spline, cubic, akima [9] and wodicka [10]. spline and akima are synonymous. All of these methods use the same syntax as table, and all of them support reading tables in from files.

It is important to note that the B-source allows the user to specify expressions that could have infinite-slope transitions, such as the following. (Note: the braces surrounding all expressions are required in this definition.)

```
Bcrtl OUTA 0 V=\{ IF((V(IN) > 3.5), 5, 0) \}
```

This can lead to "timestep too small" errors when Xyce reaches the transition point. Infinite-slope transitions in expressions dependent only on the time variable are a special case, because Xyce can detect that they are going to happen in the future and

set a "breakpoint" to capture them. Infinite-slope transitions depending on other solution variables cannot be predicted in advance, and cause the time integrator to scale back the timestep repeatedly in an attempt to capture the feature until the timestep is too small to continue.

One solution to the problem is to modify the expression to allow a continuous transition. However, this can become complicated with multiple inputs. The other solution is to specify device options or instance parameters to allow smooth transitions. The parameter <code>smoothbsrc</code> enables the smooth transitions. This is done by adding a RC network to the output of B sources. For example,

```
Bcrtl OUTA 0 V={ IF( (V(IN) > 3.5), 5, 0 ) } smoothbsrc=1 .options device smoothbsrc=1
```

The smoothness of the transition can be controlled by specifying the rc constant of the RC network. For example,

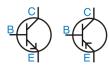
```
Bcrtl OUTA 0 V={ IF( (V(IN) > 3.5), 5, 0 ) } smoothbsrc=1 + rcconst = 1e-10
```

Note that this smoothed B-source only applies to voltage sources. The voltage behavioral source supports two instance parameters smoothbsrc and rcconst. Parameters may be provided as space separated <parameter>=<value> specifications as needed. The default value for smoothbsrc is 0 and the default for rcconst is 1e-9.

See the "Analog Behavioral Modeling" chapter of the Xyce User's Guide [1] for guidance on using the B-source device and ABM expressions, and the Expressions Section (2.2) for complete documentation of expressions and expression operators. One important note is that time-dependent expressions are supported for the current and voltage parameters of a B source, but frequency-dependent expressions are not.

B-sources were originally developed primarily to support DC and transient analysis. As such, their support for frequency domain analysis (AC and HB) has some limitations. The main limitation to be aware of is that time-dependent sources will not work with AC or HB analysis. These are sources in which the variable TIME is used in the VALUE= expression. The use case of a purely depedent B-source (depends only on other solution variables) will work with AC and HB.

## 2.3.17. Bipolar Junction Transistor (BJT)



### **Symbol**

#### **Instance Form**

Q<name> <collector node> <base node> <emitter node>
 + <substrate> [thermal node] <VBIC 1.3 4-terminal model name>

Q<name> <collector node> <base node> <emitter node>
+ <substrate> <thermal node> <HICUM model name>

#### Model Form

.MODEL <model name> NPN [model parameters]
.MODEL <model name> PNP [model parameters]

### **Examples**

Q2 10 2 9 PNP1
Q12 14 2 0 1 NPN2 2.0
Q6 VC 4 11 [SUB] LAXPNP
Q7 Coll Base Emit DT VBIC13MODEL2
Q8 Coll Base Emit VBIC13MODEL3 SW\_ET=0
Q9 Coll Base Emit Subst DT VBIC13MODEL4
Q10 Coll Base Emit Subst DT HICUMMMODEL1

# Parameters and Options

#### substrate node

Optional and defaults to ground. Since Xyce permits alphanumeric node names and because there is no easy way to make a distinction between these and the model names, the name (not a number) used for the substrate node must be enclosed in square brackets [ ]. Otherwise, nodes would be interpreted as model names. See the fourth example above.

#### area value

The relative device area with a default value of 1.

#### **Comments**

The BJT is modeled as an intrinsic transistor using ohmic resistances in series with the collector (RC/area), with the base (value varies with current, see BJT equations) and with the emitter (RE/area). For model parameters with optional names, such as VAF and VA (the optional name is in parentheses), either may be used. For model types NPN and PNP, the isolation junction capacitance is connected between the

intrinsic-collector and substrate nodes. This is the same as in SPICE and works well for vertical IC transistor structures.

Only the VBIC 1.3 model is available in Xyce 6.11 and later. The VBIC 1.3 model is provided in both 3-terminal (Q level 11) and 4-terminal (Q level 12) variants, both supporting electrothermal and excess-phase effects. These variants of the Q line are shown in the fourth through sixth examples above. VBIC 1.3 instance lines have three or four required nodes, depending on model level, and an *optional* "dt" node. The first three are the normal collector, base,and emitter. In the level 12 (4-terminal) the fourth node is the substrate, just as for the level 1 BJT. If the optional "dt" node is specified for either variant, it can be used to print the local temperature rise due to self-heating, and could possibly be used to model coupled heating effects of several VBIC devices. It is, however, unnecessary to specify a "dt" node just to print the local temperature rise, because when this node is omitted from the instance line it simply becomes and internal node, and may still be printed using the syntax N (instancename: dt). For the "Q8" example above, one could print N (Q8: dt).

As of release 6.10 of Xyce, the VBIC 1.3 3-terminal device (Q level 11) has been the subject of extensive optimization, and runs much faster than in previous releases.

#### The HICUM models require both a substrate and thermal node.

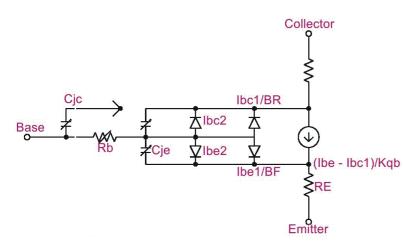


Figure 2-2. BJT model schematic. Adapted from reference [2].

**BJT Level selection** Xyce supports the level 1 BJT model, which is based on the documented standard SPICE 3F5 BJT model, but was coded independently at Sandia. It is mostly based on the classic Gummel-Poon BJT model [13].

Two variants of the VBIC model are provided as BJT levels 11 and 12. Levels 11 and 12 are the 3-terminal and 4-terminal variants of the VBIC 1.3.

An experimental release of the FBH HBT\_X model version 2.1[14] is provided as BJT level 23.

Both the HICUM/L0 (level 230) and HICUM/L2 (level 234) models are also provided (https://www.iee.et.tu-dresden.de/iee/eb/hic\_new/hic\_start.html).

The MEXTRAM[15] BJT model version 504.12.1 model is provided. Two variants of this model are available: the level 504 model without self-heating and without external substrate node, and the level 505 model with self heating but without external substrate node. The level 505 instance line requires a fourth node for the 'dt' node, similar to the usage in all of the VBIC models (levels 11-12), but is otherwise identical to the level 504 model.

**BJT Power Calculations** Power dissipated in the transistor is calculated with  $|I_B * V_{BE}| + |I_C * V_{CE}|$ , where  $I_B$  is the base current,  $I_C$  is the collector current,  $V_{BE}$  is the voltage drop between the base and the emitter and  $V_{CE}$  is the voltage drop between the collector and the emitter. This formula may differ from other simulators.

#### 2.3.17.1. The Level 1 Model

**BJT Equations** The Level 1 BJT implementation within Xyce is based on [16]. The equations in this section describe an NPN transistor. For the PNP device, reverse the signs of all voltages and currents. The equations use the following variables:

 $V_{be}$  = intrinsic base-intrinsic emitter voltage

 $V_{bc}$  = intrinsic base-intrinsic collector voltage

 $V_{bs}$  = intrinsic base-substrate voltage

 $V_{bw}$  = intrinsic base-extrinsic collector voltage (quasi-saturation only)

 $V_{bx}$  = extrinsic base-intrinsic collector voltage

 $V_{ce}$  = intrinsic collector-intrinsic emitter voltage

 $V_{is}$  = (NPN) intrinsic collector-substrate voltage

= (PNP) intrinsic substrate-collector voltage

 $V_t = kT/q$  (thermal voltage)

 $V_{th}$  = threshold voltage

k = Boltzmann's constant

q = electron charge

T = analysis temperature (K)

 $T_0$  = nominal temperature (set using **TNOM** option)

Other variables are listed above in BJT Model Parameters.

**DC Current** The BJT model is based on the Gummel and Poon model [17] where the different terminal currents are written

$$I_e = -I_{cc} - I_{be} + I_{re} + (C_{dife} + C_{de}) \frac{dV_{be}}{dt}$$

$$I_c = -I_{cc} + I_{bc} - I_{rc} - (C_{difc} + C_{dc}) \frac{dV_{bc}}{dt}$$

$$I_b = I_e - I_c$$

Here,  $C_{dife}$  and  $C_{difc}$  are the capacitances related to the hole charges per unit area in the base,  $Q_{dife}$  and  $Q_{difc}$ , affiliated with the electrons introduced across the emitter-base and collector-base junctions,

respectively. Also,  $C_{be}$  and  $C_{bc}$  are the capacitances related to donations to the hole charge of the base,  $Q_{be}$  and  $Q_{bc}$ , affiliated with the differences in the depletion regions of the emitter-base and collector-base junctions, respectively. The intermediate currents used are defined as

$$-I_{be} = \frac{\mathbf{IS}}{\mathbf{BF}} \left[ \exp\left(\frac{V_{be}}{\mathbf{NF}V_{th}}\right) - 1 \right]$$

$$-I_{cc} = \frac{Q_{bo}}{Q_b} \mathbf{IS} \left[ \exp\left(\frac{V_{be}}{\mathbf{NF}V_{th}}\right) - \exp\left(\frac{V_{bc}}{\mathbf{NF}V_{th}}\right) \right]$$

$$-I_{bc} = \frac{\mathbf{IS}}{\mathbf{BR}} \left[ \exp\left(\frac{V_{bc}}{\mathbf{NR}V_{th}}\right) - 1 \right]$$

$$I_{re} = \mathbf{ISE} \left[ \exp\left(\frac{V_{be}}{\mathbf{NE}V_{th}}\right) - 1 \right]$$

$$I_{rc} = \mathbf{ISC} \left[ \exp\left(\frac{V_{bc}}{\mathbf{NC}V_{th}}\right) - 1 \right]$$

where the last two terms are the generation/recombination currents related to the emitter and collector junctions, respectively. The charge  $Q_b$  is the majority carrier charge in the base at large injection levels and is a key difference in the Gummel-Poon model over the earlier Ebers-Moll model. The ratio  $Q_b/Q_{bo}$  (where  $Q_{bo}$  represents the zero-bias base charge, i.e. the value of  $Q_b$  when  $V_{be} = V_{bc} = 0$ ) as computed by Xyce is given by

$$\frac{Q_b}{Q_{ba}} = \frac{q_1}{2} \left( 1 + \sqrt{1 + 4q_2} \right)$$

where

$$q_{1} = \left(1 - \frac{V_{be}}{\mathbf{VAR}} - \frac{V_{bc}}{\mathbf{VAF}}\right)^{-1}$$

$$q_{2} = \frac{\mathbf{IS}}{\mathbf{IKF}} \left[ \exp\left(\frac{V_{be}}{\mathbf{NF}V_{th}}\right) - 1 \right] + \frac{\mathbf{IS}}{\mathbf{IKR}} \left[ \exp\left(\frac{V_{bc}}{\mathbf{NR}V_{th}}\right) - 1 \right]$$

**Capacitance Terms** The capacitances listed in the above DC I-V equations each consist of a depletion layer capacitance  $C_d$  and a diffusion capacitance  $C_{dif}$ . The first is given by

$$C_d = \begin{cases} \mathbf{CJ} \left( 1 - \frac{V_{di}}{\mathbf{VJ}} \right)^{-\mathbf{M}} & V_{di} \leq \mathbf{FC} \cdot \mathbf{VJ} \\ \mathbf{CJ} \left( 1 - \mathbf{FC} \right)^{-(1+\mathbf{M})} \left[ 1 - \mathbf{FC} (1+\mathbf{M}) + \mathbf{M} \frac{V_{di}}{\mathbf{VJ}} \right] & V_{di} > \mathbf{FC} \cdot \mathbf{VJ} \end{cases}$$

where CJ = CJE for  $C_{de}$ , and where CJ = CJC for  $C_{dc}$ . The diffusion capacitance (sometimes referred to as the transit time capacitance) is

$$C_{dif} = \mathbf{TT}G_d = \mathbf{TT}\frac{dI}{dV_{di}}$$

where *I* is the diode DC current given,  $G_d$  is the corresponding junction conductance, and where  $\mathbf{TT} = \mathbf{TF}$  for  $C_{dife}$  and  $\mathbf{TT} = \mathbf{TR}$  for  $C_{dife}$ .

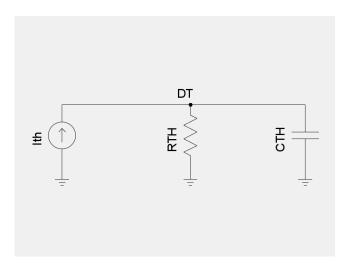


Figure 2-3. VBIC thermal network schematic.

**Temperature Effects** SPICE temperature effects are default, but all levels of the BJT have a more advanced temperature compensation available. By specifying TEMPMODEL=QUADRATIC in the netlist, parameters can be interpolated quadratically between measured values extracted from data. In the BJT, IS and ISE are interpolated logarithmically because they can change over an order of magnitude or more for temperature ranges of interest. See the Section 2.1.21.3 for more details on how to include quadratic temperature effects.

For further information on BJT models, see [17]. For a thorough description of the U.C. Berkeley SPICE models see Reference [18].

#### 2.3.17.2. VBIC Temperature Considerations

The VBIC (Q levels 11 and 12) model both support a self-heating model. The model works by computing the power dissipated by all branches of the device, applying this power as a flow through a small thermal network consisting of a power flow ("current") source through a thermal resistance and thermal capacitance, as shown in Figure 2-3. The circuit node DT will therefore be the "thermal potential" (temperature) across the parallel thermal resistance and capacitance. This temperature is the temperature rise due to self heating of the device, which is added to the ambient temperature and TRISE parameter to obtain the device operating temperature.

In VBIC 1.3, the dt node is optional on the netlist line. If not given, the dt node is used internally for thermal effects calculations, but not accessible from the rest of the netlist. The VBIC 1.3 provides an instance parameter SW\_ET that may be set to zero to turn off electrothermal self-heating effects. When set to zero, no thermal power is sourced into the dt node. This parameter defaults to 1, meaning that thermal power is computed and flows into dt even when dt is unspecified on the netlist and remains an internal node.

In VBIC 1.3, setting RTH to zero does *NOT* disable the self-heating model, and does not short the dt node to ground, even though one might expect that to be the behavior. Rather, it simply removes the RTH resistor from the equivalent circuit of figure 2-3 and leaves the dt node floating. This is an important point to recognize when using the VBIC.

If a node name is given as the fourth node of a VBIC Xyce will emit warnings about the node not having a DC path to ground and being connected to only one device. These warnings may safely be ignored, and are a harmless artifact of Xyce's connectivity checker. It is possible to silence this warning by adding a very large resistance between the dt node and ground — 1GOhm or 1TOhm are effectively the same as leaving the node floating, and will satisfy the connectivity checker's tests. This used to be the recommended means of silencing the connectivity checker for the VBIC 1.2 where dt was a required node, but it is safe *if and only if a nonzero* RTH *value is specified for the device*. If, however, RTH is zero, then dt would otherwise be floating and your external resistance now becomes the primary path for thermal power flow; rather than turning off self-heating effects, it will be as if you had set RTH to a very large value. We therefore recommend that you not tie the dt node to ground via a resistor, and if you are not using it to connect VBIC devices together via a thermal network, simply leave off the dt node to silence the connectivity checker warning. Turn off self-heating effects ONLY by setting the SW\_ET instance parameter to zero.

Users of earlier versions of Xyce may have been using the VBIC 1.2 model that was removed in release 6.11. All netlists containing the old level=10 VBIC 1.2 model must be modified to run in Xyce 6.11 and later. The following points should be observed when converting an old VBIC 1.2 netlist and model card to VBIC 1.3.

- Generally speaking, most VBIC 1.2 model cards can be converted to VBIC 1.3 model cards by the simple substitution of level=11 for level=10, with the following provisos.
- VBIC 1.2 in Xyce 6.10 and earlier did not support excess phase effects, and so the TD parameter governing excess phase was ignored.

The Xyce team has observed that some users' VBIC 1.2 parameter extractions have a non-zero value for the TD parameter. The impact of this is twofold:

- Circuits that use such model cards with only the level number changed will likely not produce identical results when compared to simulation results of older versions of Xyce using VBIC 1.2 due to the excess phase effects. If strict comparison between VBIC 1.3 runs with Xyce 6.11 or later against older runs with VBIC 1.2 is desired, change the TD parameter to zero. This will disable the excess phase effects and make VBIC 1.3 equivalent to the VBIC 1.2 that was previously provided.
- The Xyce team has seen some instances where the previously ignored TD parameter value is such that Xyce will fail to converge when the equivalent VBIC 1.3 model is substituted. The VBIC 1.2 behavior can be recovered by setting the model parameter TD to zero, which will disable the excess phase effect in VBIC 1.3. We can only suggest that the model card be re-extracted using VBIC 1.3 to determine the correct value for TD.
- VBIC 1.2 had a model parameter called DTEMP, which Xyce also recognized on the instance line. In VBIC 1.3 this parameter has been replaced by another called TRISE, which is only an instance parameter, and is unrecognized in model cards. VBIC 1.3 also recognizes DTEMP on the instance line as an alias for TRISE. If you had been specifying DTEMP in your VBIC 1.2 model cards, you will need to move it to the instance line instead in order for the parameter to be properly recognized by both VBIC 1.2 and VBIC 1.3.
- Turning off self-heating effects in VBIC 1.2 was done by grounding the mandatory dt node. This is not the recommended way of disabling self-heating in VBIC 1.3. To disable self-heating, set the SW ET parameter to zero on the instance line (as is done in the "Q8" example above).

- If not using the dt node as a way of thermally coupling devices to each other, leave it off of VBIC 1.3 instance lines, allowing it to be an internal variable irrespective of whether self-heating is enabled or not. This will silence any connectivity warnings from Xyce. Since the dt node may be printed using the N() syntax even when internal, it is unnecessary to put a dt node on the instance line just to print the local temperature rise due to self-heating. The only reasons to include it on the instance line would be for backward compatibility to VBIC 1.2 netlists, or to implement a thermal coupling network between devices.
- Finally, VBIC 1.3 introduced a number of constraints on model parameters that the previous version did not. Xyce will emit warnings if any parameter on a VBIC 1.3 model card is out of the range specified by the VBIC 1.3 authors. These warnings should not be ignored lightly, as they indicate that the model is being used in a manner not intended by its authors. They are generally a sign that the model may not be well-behaved, and may indicate an improperly extracted model card.

#### 2.3.17.3. Level 1 BJT Tables

**Table 2-65. Bipolar Junction Transistor Device Instance Parameters** 

|           | •  |                  |                        |
|-----------|--|------------------|------------------------|
| Parameter | Description  | Units            | Default                |
| AREA      | Relative device area   | -                | 1                      |
| IC1       | Vector of initial values: Vbe,Vce. Vbe=IC1                                   | V                | 0                      |
| IC2       | Vector of initial values: Vbe,Vce. Vce=IC2                                   | V                | 0                      |
| LAMBERTW  | Flag for toggling the use of the lambert-W function instead of exponentials. | logical<br>(T/F) | false                  |
| OFF       | Initial condition of no voltage drops accross device                         | logical<br>(T/F) | false                  |
| TEMP      | Device temperature   | °C               | Ambient<br>Temperature |

**Table 2-66. Bipolar Junction Transistor Device Model Parameters** 

| Parameter | Description                                  | Units | Default |
|-----------|--|-------|---------|
| AF        | Flicker noise exponent                       | _     | 1       |
| BF        | Ideal maximum foward beta                    | -     | 100     |
| BFM       | Ideal maximum foward beta                    | -     | 100     |
| BR        | Ideal maximum reverse beta                   | -     | 1       |
| BRM       | Ideal maximum reverse beta                   | _     | 1       |
| BV        | Reverse early voltage                        | V     | 0       |
| C2        | Coefficient for base-emitter leak current.   | _     | 0       |
| C4        | Coefficient for base-collector leak current. | _     | 0       |
| CCS       | Substrate zero-bias p-n capacitance          | F     | 0       |
| CDIS      | Fraction of CJC connected internally to RB   | _     | 1       |
| CJC       | Base-collector zero-bias p-n capacitance     | F     | 0       |

**Table 2-66. Bipolar Junction Transistor Device Model Parameters** 

| Parameter | Description                                   | Units | Default |
|-----------|---|-------|---------|
| CJE       | Base-emitter zero-bias p-n capacitance        | F     | 0       |
| CJS       | Substrate zero-bias p-n capacitance           | F     | 0       |
| CSUB      | Substrate zero-bias p-n capacitance           | F     | 0       |
| EG        | Bandgap voltage (barrier highth)              | eV    | 1.11    |
| ESUB      | Substrate p-n grading factor                  | _     | 0       |
| FC        | Foward-bias depletion capacitor coefficient   | _     | 0.5     |
| IK        | Corner for foward-beta high-current roll-off  | A     | 0       |
| IKF       | Corner for foward-beta high-current roll-off  | A     | 0       |
| IKR       | Corner for reverse-beta high-current roll-off | A     | 0       |
| IOB       | Current at which RB falls off by half         | A     | 0       |
| IRB       | Current at which RB falls off by half         | A     | 0       |
| IS        | Transport saturation current                  | A     | 1e-16   |
| ISC       | Base-collector leakage saturation current     | A     | 0       |
| ISE       | Base-emitter leakage saturation current       | A     | 0       |
| ITF       | Transit time dependancy on IC                 | _     | 0       |
| JBF       | Corner for foward-beta high-current roll-off  | A     | 0       |
| JBR       | Corner for reverse-beta high-current roll-off | A     | 0       |
| JLC       | Base-collector leakage saturation current     | A     | 0       |
| JLE       | Base-emitter leakage saturation current       | A     | 0       |
| JRB       | Current at which RB falls off by half         | A     | 0       |
| JTF       | Transit time dependancy on IC                 | _     | 0       |
| KF        | Flicker noise coefficient                     | _     | 0       |
| MC        | Base-collector p-n grading factor             | _     | 0.33    |
| ИЕ        | Base-emitter p-n grading factor               | _     | 0.33    |
| MJC       | Base-collector p-n grading factor             | _     | 0.33    |
| MJE       | Base-emitter p-n grading factor               | -     | 0.33    |
| MJS       | Substrate p-n grading factor                  | -     | 0       |
| MS        | Substrate p-n grading factor                  | _     | 0       |
| NC        | Base-collector leakage emission coefficient   | -     | 2       |
| NE        | Base-emitter leakage emission coefficient     | -     | 1.5     |
| NF        | Foward current emission coefficient           | -     | 1       |
| NK        | High current rolloff coefficient              | _     | 0.5     |
| NKF       | High current rolloff coefficient              | _     | 0.5     |
| NLE       | Base-emitter leakage emission coefficient     | _     | 1.5     |
| NR        | Reverse current emission coefficient          | _     | 1       |
| PC        | Base-collector built-in potential             | V     | 0.75    |

**Table 2-66. Bipolar Junction Transistor Device Model Parameters** 

| Parameter | Description  | Units  | Default                |
|-----------|--|--------|------------------------|
| PE        | Base-emitter built-in potential                                | V      | 0.75                   |
| PS        | Substrate built-in potential                                   | V      | 0.75                   |
| PSUB      | Substrate built-in potential                                   | V      | 0.75                   |
| PT        | Temperature exponent for IS. (synonymous with XTI)             | _      | 3                      |
| PTF       | Excess Phase at 1/(2pi*TF) Hz                                  | degree | 0                      |
| RB        | Zero-bias (maximum) base resistance                            | Ω      | 0                      |
| RBM       | Maximum base resistance  | Ω      | 0                      |
| RC        | Collector ohmic resistance                                     | Ω      | 0                      |
| RE        | Emitter ohmic resistance                                       | Ω      | 0                      |
| TB        | Foward and reverse beta temperature coefficient                | _      | 0                      |
| TCB       | Foward and reverse beta temperature coefficient                | _      | 0                      |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature | -      | 'NONE'                 |
| TF        | Ideal foward transit time                                      | s      | 0                      |
| TNOM      | Parameter measurement temperature                              | °C     | Ambient<br>Temperature |
| TR        | Ideal reverse transit time                                     | S      | 0                      |
| VA        | Foward early voltage   | V      | 0                      |
| VAF       | Foward early voltage   | V      | 0                      |
| VAR       | Reverse early voltage  | V      | 0                      |
| VB        | Reverse early voltage  | V      | 0                      |
| VBF       | Foward early voltage   | V      | 0                      |
| VJC       | Base-collector built-in potential                              | V      | 0.75                   |
| VJE       | Base-emitter built-in potential                                | V      | 0.75                   |
| VJS       | Substrate built-in potential                                   | V      | 0.75                   |
| VRB       | Reverse early voltage  | V      | 0                      |
| VTF       | Transit time dependancy on Vbc                                 | V      | 0                      |
| XCJC      | Fraction of CJC connected internally to RB                     | _      | 1                      |
| XTB       | Foward and reverse beta temperature coefficient                | _      | 0                      |
| XTF       | Transit time bias dependence coefficient                       | _      | 0                      |
| XTI       | Temperature exponent for IS. (synonymous with PT)              | _      | 3                      |

## 2.3.17.4. Level 11 and 12 BJT Tables (VBIC 1.3)

The VBIC 1.3 (level 11 transistor for 3-terminal, level 12 for 4-terminal) supports a number of instance parameters that are not available in the VBIC 1.2. The level 11 and level 12 differ only by the number of required nodes. The level 11 is the 3-terminal device, having only collector, base, and emitter as required

nodes. The level 12 is the 4-terminal device, requiring collector, base, emitter and substrate nodes. Both models support an optional 'dt' node as their last node on the instance line.

Model cards extracted for the VBIC 1.2 will mostly work with the VBIC 1.3, with one notable exception: in VBIC 1.2 the DTEMP parameter was a model parameter, and Xyce allowed it also to be specified on the instance line, overriding whatever was specified in the model. This parameter was replaced in VBIC 1.3 with the TRISE parameter, which is *only* an instance parameter. DTEMP and DTA are both supported as aliases for the TRISE instance parameter.

Table 2-67. VBIC 1.3 3T Device Instance Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DTA       | Alias for trise  | °C    | 0       |
| DTEMP     | Alias for trise  | °C    | 0       |
| M         | multiplicity factor                                      | _     | 1       |
| SW_ET     | switch for self-heating: 0=no and 1=yes                  | _     | 1       |
| SW_NOISE  | switch for including noise: 0=no and 1=yes               | _     | 1       |
| TRISE     | local temperature delta to ambient (before self-heating) | °C    | 0       |

Table 2-68. VBIC 1.3 3T Device Model Parameters

| Parameter | Description                                   | Units    | Default |
|-----------|---|----------|---------|
| ABK       | SiGe base current kink exponent               | _        | 1       |
| AFN       | b-e flicker noise current exponent            | _        | 1       |
| AJC       | b-c capacitance smoothing factor              | _        | -0.5    |
| AJE       | b-e capacitance smoothing factor              | _        | -0.5    |
| AJS       | c-s capacitance smoothing factor              | _        | -0.5    |
| ART       | smoothing parameter for reach-through         | _        | 0.1     |
| AVC1      | b-c weak avalanche parameter 1                | $V^{-1}$ | 0       |
| AVC2      | b-c weak avalanche parameter 2                | _        | 0       |
| AVCX1     | bx-cx weak avalanche parameter 1              | $V^{-1}$ | 0       |
| AVCX2     | bx-cx weak avalanche parameter 2              | _        | 0       |
| BBK       | SiGe base current kink current factor         | A        | 0       |
| BFN       | b-e flicker noise 1/f exponent                | _        | 1       |
| CBCO      | extrinsic b-c overlap capacitance             | F        | 0       |
| CBEO      | extrinsic b-e overlap capacitance             | F        | 0       |
| CCSO      | extrinsic c-s overlap capacitance             | F        | 0       |
| CJC       | zero-bias b-c depletion capacitance           | F        | 0       |
| CJCP      | zero-bias extrinsic c-s depletion capacitance | F        | 0       |
| CJE       | zero-bias b-e depletion capacitance           | F        | 0       |
| CJEP      | zero-bias extrinsic b-c depletion capacitance | F        | 0       |

Table 2-68. VBIC 1.3 3T Device Model Parameters

| Parameter | Description   | Units         | Default |
|-----------|---|---------------|---------|
| СТН       | thermal capacitance                                 | _             | 0       |
| DEAR      | delta activation energy for isrr                    | V             | 0       |
| EA        | activation energy for is                            | V             | 1.12    |
| EAIC      | activation energy for ibci and ibeip                | V             | 1.12    |
| EAIE      | activation energy for ibei                          | V             | 1.12    |
| EAIS      | activation energy for ibcip                         | V             | 1.12    |
| EANC      | activation energy for iben and ibenp                | V             | 1.12    |
| EANE      | activation energy for iben                          | V             | 1.12    |
| EANS      | activation energy for ibcnp                         | V             | 1.12    |
| EAP       | activation energy for isp                           | V             | 1.12    |
| FC        | forward bias depletion capacitance limit            | _             | 0.9     |
| GAMM      | epi doping parameter                                | _             | 0       |
| GMIN      | minimum conductance                                 | $\Omega^{-1}$ | 1e-12   |
| HRCF      | high current collector resistance factor            | _             | 0       |
| IBBE      | b-e breakdown current                               | A             | 1e-06   |
| IBCI      | ideal b-c saturation current                        | A             | 1e-16   |
| IBCIP     | ideal parasitic b-c saturation current              | A             | 0       |
| IBCN      | non-ideal b-c saturation current                    | A             | 0       |
| IBCNP     | non-ideal parasitic b-c saturation current          | A             | 0       |
| IBEI      | ideal b-e saturation current                        | A             | 1e-18   |
| IBEIP     | ideal parasitic b-e saturation current              | A             | 0       |
| IBEN      | non-ideal b-e saturation current                    | A             | 0       |
| IBENP     | non-ideal parasitic b-e saturation current          | A             | 0       |
| IBK0      | SiGe base current kink current reference            | A             | 0       |
| IKF       | forward knee current (zero=infinite)                | A             | 0       |
| IKP       | parasitic knee current (zero=infinite)              | A             | 0       |
| IKR       | reverse knee current (zero=infinite)                | A             | 0       |
| IS        | transport saturation current                        | A             | 1e-16   |
| ISP       | parasitic transport saturation current              | A             | 0       |
| ISRR      | ratio of is(reverse) to is(forward)                 | _             | 1       |
| ITF       | tf coefficient of Ic dependence                     | A             | 0       |
| KFN       | b-e flicker noise constant                          | _             | 0       |
| MAXEXP    | argument at which to linearize general exponentials | _             | 1e+22   |
| MC        | b-c grading coefficient                             | _             | 0.33    |
| MCX       | bx-cx grading coefficient for avalanche             | _             | 0.33    |
| <br>ME    | b-e grading coefficient                             |               | 0.33    |

Table 2-68. VBIC 1.3 3T Device Model Parameters

| No.   | Parameter | Description  | Units                     | Default |
|---|-----------|--|---------------------------|---------|
| MCI   ideal b-c emission coefficient   —   1  | MS        | c-s grading coefficient                              |                           | 0.33    |
| ideal parasitic b-c emission coefficient — 1 NCN non-ideal b-c emission coefficient — 2 NCNP non-ideal parasitic b-c emission coefficient — 2 NCNP non-ideal b-c emission coefficient — 1 NEN non-ideal b-c emission coefficient — 1 NEN non-ideal b-c emission coefficient — 2 NEN non-ideal b-c emission coefficient (ideality factor) — 1 NEN non parasitic emission coefficient (ideality factor) — 1 NEN non non-ideal b-c b-c built-in potential V 0.75 NEN non non-ideal b-c b-c built-in potential V 0.75 NEN non non-ideal b-c b-c built-in potential V 0.75 NEN non non-ideal b-c b-c built-in potential V 0.75 NEN non non-ideal b-c b-c built-in potential V 0.75 NEN non non-ideal b-c b-c built-in potential V 0.75 NEN non-ideal b-c b-c b-c built-in potential V 0.75 NEN non-ideal b-c b-c built-in potential V 0.75 NEN non-ideal b-c b-c b-c built-in potential V 0.75 NEN non-ideal b-c built-in poten   | NBBE      | b-e breakdown emission coefficient                   |                           | 1       |
| NCN         non-ideal b-c emission coefficient         —         2           NCNP         non-ideal parasitic b-c emission coefficient         —         2           NEI         ideal b-e emission coefficient         —         1           NEN         non-ideal be-emission coefficient         —         2           NEP         fwd emission coefficient (ideality factor)         —         1           NEP         parasitic emission coefficient (ideality factor)         —         1           NEP         parasitic emission coefficient (ideality factor)         —         1           NEP         parasitic emission coefficient (ideality factor)         —         0           NEP         parasitic emission coefficient (ideality factor)         —         1           NEP         parasitic emission coefficient (ideality factor)         —         0           NEP         parasitic emission coefficient (ideality factor)         —         1           NEP         parasitic emission coefficient (ideality factor)         —         0           NEP         parasitic emission coefficient (ideality factor)         —         1           PLO         parasitic emission coefficient (ideality factor)         —         0           PLO         pp parasitic emission coefficient (ideali   | NCI       | ideal b-c emission coefficient                       | _                         | 1       |
| NORDE   non-ideal parasitic b-c emission coefficient   —   2   NET   ideal b-c emission coefficient   —   1   NEN   non-ideal b-e emission coefficient   —   2   NET   fwd emission coefficient (ideality factor)   —   1   NET   parasitic emitsion coefficient (ideality factor)   —   1   NET   high current beta roll-off parameter   —   0.5   NEW   high current beta roll-off parameter   —   0.5   NEW   npn transistor type   —   0   NEW   rev emission coefficient (ideality factor)   —   1   NEW   he b-c built-in potential   V   0.75   NEW   D-c b-c b-c b-c b-c b-c b-c b-c b-c b-c b  | NCIP      | ideal parasitic b-c emission coefficient             | _                         | 1       |
| NEEL       ideal b-e emission coefficient       —       1         NEEN       non-ideal b-e emission coefficient       —       2         NEF       fwd emission coefficient (ideality factor)       —       1         NEF       high current beta roll-off parameter       —       0.5         NEF       high current beta roll-off parameter       —       0         NEF       high current beta roll-off parameter       —       0         PC       b-c built-in potential       V       0.75         PE       b-e built-in potential       V       0.75         PPAP       prop transistor type       —       0         PCS       c-s built-in potential       V       0.75         PPAP       prop transistor type       —       0         PCS       c-s built-in potential       V       0.75         PCS       c-s built-in potential       V       0.75   | NCN       | non-ideal b-c emission coefficient                   | _                         | 2       |
| NEED         non-ideal b-e emission coefficient         —         2           NFF         fwd emission coefficient (ideality factor)         —         1           NFFP         parasitic emission coeff (ideality factor)         —         1           NKF         high current beta roll-off parameter         —         0.5           NEN         npn transistor type         —         0           NEN         rev emission coefficient (ideality factor)         —         1           PC         b-c built-in potential         V         0.75           PE         b-e built-in potential         V         0.75           PNJMAXI         current at which to linearize diode currents         A         1           PNPP         pnp transistor type         —         0           PS         c-s built-in potential         V         0.75           PPNP         pnp transistor type         —         0           PS         c-s built-in potential         V         0.75           DCO         epi charge parameter         C         0           QCO         epi charge parameter         C         0           QCO         epi charge parameter         C         0           QCO         ep   | NCNP      | non-ideal parasitic b-c emission coefficient         | _                         | 2       |
| NF       fwd emission coefficient (ideality factor)       —       1         NFP       parasitic emission coeff (ideality factor)       —       1         NKF       high current beta roll-off parameter       —       0.5         NFN       npn transistor type       —       0         NR       rev emission coefficient (ideality factor)       —       1         PC       b-c built-in potential       V       0.75         PE       b-e built-in potential       V       0.75         PNJMAXI       current at which to linearize diode currents       A       1         PNPP       pnp transistor type       —       0         PS       c-s built-in potential       V       0.75         DEM       base charge model selection switch: $0$ =GP and $1$ =SGP       —       0         DED       Description       —       0       0         DED       base charge model selection switch: $0$ =GP and $1$ =SGP       —       0         DED       Description       —       0       0         DED       ideal b-e quasi-neutral base recombination parameter       —       0         QNI BEIR       ideal b-e quasi-neutral base recombination parameter       —       0         QTF   | NEI       | ideal b-e emission coefficient                       | _                         | 1       |
| MEP       parasitic emission coeff (ideality factor)       —       1         MKF       high current beta roll-off parameter       —       0.5         MPN       npn transistor type       —       0         NR       rev emission coefficient (ideality factor)       —       1         PC       b-c built-in potential       V       0.75         PE       b-e built-in potential       V       0.75         PNJMAXI       current at which to linearize diode currents       A       1         PNP       pnp transistor type       —       0         PS       c-s built-in potential       V       0.75         DEM       base charge model selection switch: 0=GP and 1=SGP       —       0         DCO       epi charge parameter       C       0         DCTF       variation of tf with base-width modulation       —       0         REB1       intrin  | NEN       | non-ideal b-e emission coefficient                   | _                         | 2       |
| NKF       high current beta roll-off parameter       — $0.5$ NEN       npn transistor type       —       0         NR       rev emission coefficient (ideality factor)       —       1         PC       b-c built-in potential       V $0.75$ PEE       b-e built-in potential       V $0.75$ PNDMAXI       current at which to linearize diode currents       A       1         PNP       pnp transistor type       —       0         PS       c-s built-in potential       V $0.75$ QEM       base charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCO       epi charge parameter       C       0         QCTF       variation of tf with base-width modulation       —       0         REBI       intrinsic base   | NF        | fwd emission coefficient (ideality factor)           | _                         | 1       |
| NEN       npn transistor type       —       0         NR       rev emission coefficient (ideality factor)       —       1         PC       b-c built-in potential       V       0.75         PE       b-e built-in potential       V       0.75         PPNJMAXI       current at which to linearize diode currents       A       1         PNP       pnp transistor type       —       0         PS       c-s built-in potential       V       0.75         QBM       base charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCO       epi charge parameter       C       0         QCO       epi charge parameter       C       0         QCO       epi charge parameter       —       0         QCTF       variation of tf with base-width modulation       —       0         QTF       variation of tf with base-resistance $\Omega$ 0         REB       parasitic transistor base resistance $\Omega$ 0         REB       extrinsic base resistance $\Omega$ 0         REC       intrinsic collector resistance $\Omega$ 0         REC       intrinsic collector resistance $\Omega$ 0   | NFP       | parasitic emission coeff (ideality factor)           | _                         | 1       |
| rev emission coefficient (ideality factor) — 1  PC b-c built-in potential V 0.75  PE b-e built-in potential V 0.75  PNJMAXI current at which to linearize diode currents A 1  PNP pnpt pnpt transistor type — 0  PS c-s built-in potential V 0.75  PS c-s c-s built-in potential V 0.75  PS c-s carbonal v 0.75  PS c-s built-in potential v 0.75  PS c-s   | NKF       | high current beta roll-off parameter                 | _                         | 0.5     |
| PC       b-c built-in potential       V       0.75         PE       b-e built-in potential       V       0.75         PNJMAXI       current at which to linearize diode currents       A       1         PNP       pnp transistor type       —       0         PS       c-s built-in potential       V       0.75         QEM       base charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCO       epi charge parameter       C       0         QCO       epi charge model selection switch: 0=GP and 1=SGP       —       0 <td>NPN</td> <td>npn transistor type</td> <td></td> <td>0</td>  | NPN       | npn transistor type                                  |                           | 0       |
| PE       b-e built-in potential       V       0.75         PNJMAXI       current at which to linearize diode currents       A       1         PNP       pnp transistor type       —       0         PS       c-s built-in potential       V       0.75         QEM       base charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCO       epi charge parameter       C       0         QCO       epi charge parameter       C       0         QCO       epi charge parameter       —       0         QCO       epi charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCO       epi charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCO       epi charge model selection switch: $0$ =GP and $1$ =SGP       —       0         QCF       parameter       —       0       0         RBD   | NR        | rev emission coefficient (ideality factor)           | _                         | 1       |
| PNJMAXI current at which to linearize diode currents A 1 PNP pnp transistor type — 0 PS C-s built-in potential V 0.75  QEM base charge model selection switch: $0$ =GP and $1$ =SGP — 0 QCO epi charge parameter C 0 QDIBETR ideal b-e quasi-neutral base recombination parameter — 0 QTF variation of tf with base-width modulation — 0 REBI intrinsic base resistance $\Omega$ 0 REBP parasitic transistor base resistance $\Omega$ 0 RECI intrinsic collector resistance $\Omega$ 0 RECI intrinsic collector resistance $\Omega$ 0 RECX extrinsic emitter resistance $\Omega$ 0 RECX extrinsic substrate resistance $\Omega$ 0 RECX extrinsic emitter resistance $\Omega$ 0 RECX extrinsic parameter $\Omega$ 0 RECX extrinsic substrate resistance $\Omega$ 0 RECX extrinsic parameter $\Omega$                 | PC        | b-c built-in potential                               | V                         | 0.75    |
| PNP pnp transistor type — 0 PS c-s built-in potential V 0.75  PS c-s built-in potential V 0.75  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS compared base charge model selection switch: $0$ =GP and $1$ =SGP — 0  PS co   | PE        | b-e built-in potential                               | V                         | 0.75    |
| PS       c-s built-in potential       V       0.75         QEM       base charge model selection switch: 0=GP and 1=SGP       —       0         QCO       epi charge parameter       C       0         QNIBEIR       ideal b-e quasi-neutral base recombination parameter       —       0         QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance       Ω       0         RBP       parasitic transistor base resistance       Ω       0         RBX       extrinsic base resistance       Ω       0         RCI       intrinsic collector resistance       Ω       0         RCX       extrinsic collector resistance       Ω       0         RE       extrinsic substrate resistance       Ω       0         RES       extrinsic substrate resistance       —       0         SCALE       scale factor for instance geometries       —       1         SCALE       scale factor for instance geometries       —       0         STAVC       temperature exponent of avc2       °C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2       °C <sup>-1</sup> 0   | PNJMAXI   | current at which to linearize diode currents         | A                         | 1       |
| base charge model selection switch: $0$ =GP and $1$ =SGP — 0  QCO epi charge parameter C 0  QNIBEIR ideal b-e quasi-neutral base recombination parameter — 0  QTF variation of tf with base-width modulation — 0  RBI intrinsic base resistance $\Omega$ 0  RBP parasitic transistor base resistance $\Omega$ 0  RBX extrinsic base resistance $\Omega$ 0  RCI intrinsic collector resistance $\Omega$ 0  RCX extrinsic collector resistance $\Omega$ 0  RCX extrinsic emitter resistance $\Omega$ 0  RE extrinsic substrate resistance $\Omega$ 0  RCX thermal resistan | PNP       | pnp transistor type                                  | _                         | 0       |
| QCO       epi charge parameter       C       0         QNIBEIR       ideal b-e quasi-neutral base recombination parameter       —       0         QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RCH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SCALE       scale factor for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0   | PS        | c-s built-in potential                               | V                         | 0.75    |
| QNIBEIR       ideal b-e quasi-neutral base recombination parameter       —       0         QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SCALE       scale factor for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0  | QBM       | base charge model selection switch: 0=GP and 1=SGP   | _                         | 0       |
| QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SCALE       scale factor for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0  | QCO       | epi charge parameter                                 | С                         | 0       |
| RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance $-$ 0         SCALE       scale factor for instance geometries $-$ 1         SCALE       scale factor for instance geometries $-$ 0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0   | QNIBEIR   | ideal b-e quasi-neutral base recombination parameter | _                         | 0       |
| RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0  | QTF       | variation of tf with base-width modulation           | _                         | 0       |
| RBX       extrinsic base resistance $\Omega$ $0$ RCI       intrinsic collector resistance $\Omega$ $0$ RCX       extrinsic collector resistance $\Omega$ $0$ RE       extrinsic emitter resistance $\Omega$ $0$ RS       extrinsic substrate resistance $\Omega$ $0$ RTH       thermal resistance $ 0$ SCALE       scale factor for instance geometries $ 1$ SHRINK       shrink percentage for instance geometries $ 0$ TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> $0$ TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> $0$ TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> $0$   | RBI       | intrinsic base resistance                            | Ω                         | 0       |
| intrinsic collector resistance $\Omega$ 0  RCX extrinsic collector resistance $\Omega$ 0  RE extrinsic emitter resistance $\Omega$ 0  RS extrinsic substrate resistance $\Omega$ 0  RTH thermal resistance $\Omega$ 0  SCALE scale factor for instance geometries $\Omega$ 1  SHRINK shrink percentage for instance geometries $\Omega$ 0  TAVC temperature exponent of avc2 $\Omega$ $\Omega$ 1  TAVCX temperature exponent of rth $\Omega$ $\Omega$ $\Omega$ 1  TORTH temperature exponent of rth $\Omega$ $\Omega$ $\Omega$ 1  | RBP       | parasitic transistor base resistance                 | Ω                         | 0       |
| RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0   | RBX       | extrinsic base resistance                            | Ω                         | 0       |
| RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C $^{-1}$ 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C $^{-1}$ 0         TCRTH       temperature exponent of rth $^{\circ}$ C $^{-1}$ 0   | RCI       | intrinsic collector resistance                       | Ω                         | 0       |
| RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0  | RCX       | extrinsic collector resistance                       | Ω                         | 0       |
| RTH     thermal resistance     —     0       SCALE     scale factor for instance geometries     —     1       SHRINK     shrink percentage for instance geometries     —     0       TAVC     temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0       TAVCX     temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0       TCRTH     temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0   | RE        | extrinsic emitter resistance                         | Ω                         | 0       |
| SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0  | RS        | extrinsic substrate resistance                       | Ω                         | 0       |
| SHRINK shrink percentage for instance geometries — 0 TAVC temperature exponent of avc2 $^{\circ}C^{-1}$ 0 TAVCX temperature exponent of avcx2 $^{\circ}C^{-1}$ 0 TCRTH temperature exponent of rth $^{\circ}C^{-1}$ 0   | RTH       | thermal resistance                                   | _                         | 0       |
| TAVC temperature exponent of avc2 $^{\circ}C^{-1}$ 0 TAVCX temperature exponent of avcx2 $^{\circ}C^{-1}$ 0 TCRTH temperature exponent of rth $^{\circ}C^{-1}$ 0  | SCALE     | scale factor for instance geometries                 | _                         | 1       |
| TAVCX temperature exponent of avcx2 $^{\circ}C^{-1}$ 0 temperature exponent of rth $^{\circ}C^{-1}$ 0   | SHRINK    | shrink percentage for instance geometries            | _                         | 0       |
| TCRTH temperature exponent of rth $^{\circ}C^{-1}$ 0  | TAVC      | temperature exponent of avc2                         | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| tonipolitical and the second s  | TAVCX     | temperature exponent of avcx2                        | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TCVEF temperature exponent of vef ${}^{\circ}C^{-1}$ 0  | TCRTH     | temperature exponent of rth                          | $^{\circ}\mathrm{C}^{-1}$ | 0       |
|   | TCVEF     | temperature exponent of vef                          | $^{\circ}\mathrm{C}^{-1}$ | 0       |

Table 2-68. VBIC 1.3 3T Device Model Parameters

| Parameter | Description  | Units                     | Default |
|-----------|--|---------------------------|---------|
| TCVER     | temperature exponent of ver                                  | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TD        | forward excess-phase delay time                              | S                         | 0       |
| TF        | forward transit time   | s                         | 0       |
| TMAX      | maximum ambient temperature                                  | °C                        | 500     |
| TMAXCLIP  | clip maximum temperature                                     | °C                        | 500     |
| TMIN      | minimum ambient temperature                                  | °C                        | -100    |
| TMINCLIP  | clip minimum temperature                                     | °C                        | -100    |
| TNBBE     | temperature coefficient of nbbe                              | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TNF       | temperature exponent of nf and nr                            | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| INOM      | nominal (reference) temperature                              | °C                        | 27      |
| ľR        | reverse transit time   | s                         | 0       |
| TVBBE1    | linear temperature coefficient of vbbe                       | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TVBBE2    | quadratic temperature coefficient of vbbe                    |                           | 0       |
| TYPE      | transistor type: -1=npn and +1=pnp (overriden by npn or pnp) | _                         | -1      |
| VBBE      | b-e breakdown voltage  | V                         | 0       |
| VEF       | forward Early voltage (zero=infinite)                        | V                         | 0       |
| VER       | reverse Early voltage (zero=infinite)                        | V                         | 0       |
| VO        | epi drift saturation voltage                                 | V                         | 0       |
| VPTE      | SiGe base current kink voltage                               | V                         | 0       |
| VRT       | reach-through voltage for Cbc limiting                       | V                         | 0       |
| VTF       | tf coefficient of Vbci dependence                            | V                         | 0       |
| WBE       | partitioning of Ibe/Ibex and Qbe/Qbex                        | _                         | 1       |
| WSP       | partitioning of Iccp between Vbep and Vbci                   | _                         | 1       |
| XII       | temperature exponent of ibei, ibci, ibeip, ibcip             | _                         | 3       |
| XIKF      | temperature exponent of ikf                                  | _                         | 0       |
| XIN       | temperature exponent of iben, iben, ibenp, ibenp             | _                         | 3       |
| XIS       | temperature exponent of is                                   | _                         | 3       |
| XISR      | temperature exponent for isrr                                | _                         | 0       |
| XRB       | temperature exponent of rbx and rbi                          | _                         | 0       |
| XRBI      | temperature exponent of rbi (overrides xrb)                  | _                         | 0       |
| XRBP      | temperature exponent of rbp (overrides xrc)                  | _                         | 0       |
| XRBX      | temperature exponent of rbx (overrides xrb)                  | _                         | 0       |
| XRC       | temperature exponent of rci and rcx and rbp                  | _                         | 0       |
| XRCI      | temperature exponent of rci (overrides xrc)                  | _                         | 0       |
| XRCX      | temperature exponent of rcx (overrides xrc)                  |                           | 0       |

Table 2-68. VBIC 1.3 3T Device Model Parameters

| Parameter | Description                    | Units | Default |
|-----------|--------------------------------|-------|---------|
| XRE       | temperature exponent of re     | _     | 0       |
| XRS       | temperature exponent of rs     | _     | 0       |
| XTF       | tf bias dependence coefficient | _     | 0       |
| XVO       | temperature exponent of vo     | _     | 0       |

Table 2-69. VBIC 1.3 4T Device Instance Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DTA       | Alias for trise  | °C    | 0       |
| DTEMP     | Alias for trise  | °C    | 0       |
| M         | multiplicity factor                                      | _     | 1       |
| SW_ET     | switch for self-heating: 0=no and 1=yes                  | _     | 1       |
| SW_NOISE  | switch for including noise: 0=no and 1=yes               | _     | 1       |
| TRISE     | local temperature delta to ambient (before self-heating) | °C    | 0       |

Table 2-70. VBIC 1.3 4T Device Model Parameters

| Parameter | Description                                   | Units    | Default |
|-----------|---|----------|---------|
| ABK       | SiGe base current kink exponent               | _        | 1       |
| AFN       | b-e flicker noise current exponent            | _        | 1       |
| AJC       | b-c capacitance smoothing factor              | _        | -0.5    |
| AJE       | b-e capacitance smoothing factor              | _        | -0.5    |
| AJS       | c-s capacitance smoothing factor              | _        | -0.5    |
| ART       | smoothing parameter for reach-through         | _        | 0.1     |
| AVC1      | b-c weak avalanche parameter 1                | $V^{-1}$ | 0       |
| AVC2      | b-c weak avalanche parameter 2                | _        | 0       |
| AVCX1     | bx-cx weak avalanche parameter 1              | $V^{-1}$ | 0       |
| AVCX2     | bx-cx weak avalanche parameter 2              | _        | 0       |
| BBK       | SiGe base current kink current factor         | A        | 0       |
| BFN       | b-e flicker noise 1/f exponent                | _        | 1       |
| CBCO      | extrinsic b-c overlap capacitance             | F        | 0       |
| CBEO      | extrinsic b-e overlap capacitance             | F        | 0       |
| CCSO      | extrinsic c-s overlap capacitance             | F        | 0       |
| CJC       | zero-bias b-c depletion capacitance           | F        | 0       |
| CJCP      | zero-bias extrinsic c-s depletion capacitance | F        | 0       |
| CJE       | zero-bias b-e depletion capacitance           | F        | 0       |
| CJEP      | zero-bias extrinsic b-c depletion capacitance | F        | 0       |
| СТН       | thermal capacitance                           | _        | 0       |
| DEAR      | delta activation energy for isrr              | V        | 0       |
| EA        | activation energy for is                      | V        | 1.12    |
| EAIC      | activation energy for ibci and ibeip          | V        | 1.12    |
| EAIE      | activation energy for ibei                    | V        | 1.12    |
| EAIS      | activation energy for ibcip                   | V        | 1.12    |
| EANC      | activation energy for iben and ibenp          | V        | 1.12    |
|           |   |          |         |

Table 2-70. VBIC 1.3 4T Device Model Parameters

| Parameter | Description   | Units         | Default |
|-----------|---|---------------|---------|
| EANE      | activation energy for iben                          | V             | 1.12    |
| EANS      | activation energy for ibcnp                         | V             | 1.12    |
| EAP       | activation energy for isp                           | V             | 1.12    |
| FC        | forward bias depletion capacitance limit            | _             | 0.9     |
| GAMM      | epi doping parameter                                | _             | 0       |
| GMIN      | minimum conductance                                 | $\Omega^{-1}$ | 1e-12   |
| HRCF      | high current collector resistance factor            | _             | 0       |
| IBBE      | b-e breakdown current                               | A             | 1e-06   |
| IBCI      | ideal b-c saturation current                        | A             | 1e-16   |
| IBCIP     | ideal parasitic b-c saturation current              | A             | 0       |
| IBCN      | non-ideal b-c saturation current                    | A             | 0       |
| IBCNP     | non-ideal parasitic b-c saturation current          | A             | 0       |
| IBEI      | ideal b-e saturation current                        | A             | 1e-18   |
| IBEIP     | ideal parasitic b-e saturation current              | A             | 0       |
| IBEN      | non-ideal b-e saturation current                    | A             | 0       |
| IBENP     | non-ideal parasitic b-e saturation current          | A             | 0       |
| IBK0      | SiGe base current kink current reference            | A             | 0       |
| IKF       | forward knee current (zero=infinite)                | A             | 0       |
| IKP       | parasitic knee current (zero=infinite)              | A             | 0       |
| IKR       | reverse knee current (zero=infinite)                | A             | 0       |
| IS        | transport saturation current                        | A             | 1e-16   |
| ISP       | parasitic transport saturation current              | A             | 0       |
| ISRR      | ratio of is(reverse) to is(forward)                 | _             | 1       |
| ITF       | tf coefficient of Ic dependence                     | A             | 0       |
| KFN       | b-e flicker noise constant                          | _             | 0       |
| MAXEXP    | argument at which to linearize general exponentials | _             | 1e+22   |
| MC        | b-c grading coefficient                             | _             | 0.33    |
| MCX       | bx-cx grading coefficient for avalanche             | _             | 0.33    |
| ME        | b-e grading coefficient                             | _             | 0.33    |
| MS        | c-s grading coefficient                             | _             | 0.33    |
| NBBE      | b-e breakdown emission coefficient                  | _             | 1       |
| NCI       | ideal b-c emission coefficient                      | _             | 1       |
| NCIP      | ideal parasitic b-c emission coefficient            | _             | 1       |
| NCN       | non-ideal b-c emission coefficient                  | _             | 2       |
| NCNP      | non-ideal parasitic b-c emission coefficient        |               | 2       |
| NEI       | ideal b-e emission coefficient                      | _             | 1       |
|           |   |               |         |

Table 2-70. VBIC 1.3 4T Device Model Parameters

| NEN  | Parameter | Description  | Units                     | Default |
|--|-----------|--|---------------------------|---------|
| NEFP   parasitic emission coeff (ideality factor)   —   1  | NEN       | non-ideal b-e emission coefficient                   |                           | 2       |
| NKF high current beta roll-off parameter — 0.5 NPN npn transistor type — 0 NR rev emission coefficient (ideality factor) — 1 PC bc built-in potential V 0.75 PE bc built-in potential V 0.75 PPNJMAXI current at which to linearize diode currents A 1 PPNP ppnp transistor type — 0 PS c-s built-in potential V 0.75 PS CEM base charge model selection switch: 0=GP and 1=SGP — 0 PG CO epi charge parameter C 0 PG CO epi charge parameter C 0 PG CO potential intrinsic base resistance C 0 PG CO parasitio transistor base resistance C 0 PG CO parasitic transistor base resistance C 0 PG CO PARASI PPNP PPNP PPNP PPNP PPNP PPNP PPNP PP   | NF        | fwd emission coefficient (ideality factor)           |                           | 1       |
| NEN         npn transistor type         —         0           NR         rev emission coefficient (ideality factor)         —         1           PC         b-c built-in potential         V         0.75           PE         b-e built-in potential         V         0.75           PNJMAXI         current at which to linearize diode currents         A         1           PNP         pnp transistor type         —         0           PS         c-s built-in potential         V         0.75           QCO         epi charge parameter         C         0           QCO         QC         QD         0.75  | NFP       | parasitic emission coeff (ideality factor)           |                           | 1       |
| PC   | NKF       | high current beta roll-off parameter                 | _                         | 0.5     |
| PC         b-c built-in potential         V         0.75           PE         b-e built-in potential         V         0.75           PNJMAXI         current at which to linearize diode currents         A         1           PNP         pnp transistor type         —         0           PS         c-s built-in potential         V         0.75           QSM         base charge model selection switch: 0=GP and 1=SGP         —         0           QCO         epi charge parameter         C         0           QCO         epi charge parameter         C         0           QCTF         variation of if with base-width modulation         —         0           QTF         variation of if with base-width modulation         —         0           RBI         intrinsic base resistance         Ω         0           RBB         parasitic transistor base resistance         Ω         0           RBK         extrinsic base resistance         Ω         0           RCI         intrinsic collector resistance         Ω         0           RCX         extrinsic collector resistance         Ω         0           RE         extrinsic substrate resistance         Ω         0           <   | NPN       | npn transistor type                                  | _                         | 0       |
| FE         be built-in potential         V         0.75           PNJMAXI         current at which to linearize diode currents         A         I           PNP         pnp transistor type         —         0           PS         c-s built-in potential         V         0.75           QEM         base charge model selection switch: 0=GP and 1=SGP         —         0           QCO         epi charge parameter         C         0           QUISELIR         ideal be-quasi-neutral base recombination parameter         —         0           QTF         variation of if with base-width modulation         —         0           QTF         variation of if with base-width modulation         —         0           RBI         intrinsic base resistance         Ω         0           RBP         parasitic transistor base resistance         Ω         0           RBE         extrinsic base resistance         Ω         0           RCI         intrinsic collector resistance         Ω         0           RCX         extrinsic collector resistance         Ω         0           RCX         extrinsic collector resistance         Ω         0           RCX         extrinsic substrate resistance         Ω  | NR        | rev emission coefficient (ideality factor)           | _                         | 1       |
| PNJMAXI current at which to linearize diode currents A 1 PNP pnp transistor type — 0 PS c-s built-in potential V 0.75 QBM base charge model selection switch: 0=GP and 1=SGP — 0 QCO epi charge parameter C 0 QNIBEIR ideal b-e quasi-neutral base recombination parameter — 0 QTF variation of if with base-width modulation — 0 RBI intrinsic base resistance Ω 0 RBP parasitic transistor base resistance Ω 0 RBC extrinsic collector resistance Ω 0 RCC extrinsic collector resistance Ω 0 RCC extrinsic emitter resistance Ω 0 RCC extrinsic emitter resistance Ω 0 RCC extrinsic substrate resistance Ω 0 RCC extrinsic emitter resistance 0   | PC        | b-c built-in potential                               | V                         | 0.75    |
| PNP pnp transistor type — 0 PS c-s built-in potential V 0.75  QEM base charge model selection switch: 0=GP and 1=SGP — 0 QCO epi charge parameter C 0 QMIBEIR ideal b-e quasi-neutral base recombination parameter — 0 QCTF variation of tf with base-width modulation — 0 REBI intrinsic base resistance Ω 0 REBP parasitic transistor base resistance Ω 0 REBX extrinsic base resistance Ω 0 RECX extrinsic collector resistance Ω 0 RECX extrinsic collector resistance Ω 0 RECX extrinsic emitter resistance Ω 0 RES extrinsic substrate resistance Ω 0 RES extrinsic substrate resistance Ω 0 RES extrinsic substrate resistance Ω 0 RESCALE scale factor for instance geometries — 1 RECX temperature exponent of avc2 °C-1 0 RECX temperature exponent of rh °C-1 0 RECX temperature exponent of rh °C-1 0 RECX temperature exponent of ver °C-1 0 REX temperature exponent of ver °C-1  | PE        | b-e built-in potential                               | V                         | 0.75    |
| PS       c-s built-in potential       V       0.75         QBM       base charge model selection switch: 0=GP and 1=SGP       —       0         QCO       epi charge parameter       C       0         QNIBEIR       ideal b-e quasi-neutral base recombination parameter       —       0         QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance       Ω       0         RBP       parasitic transistor base resistance       Ω       0         RBX       extrinsic base resistance       Ω       0         RCI       intrinsic collector resistance       Ω       0         RCX       extrinsic collector resistance       Ω       0         RE       extrinsic emitter resistance       Ω       0         RE       extrinsic substrate resistance       Ω       0         RES       extrinsic substrate resistance $-$ 0         SCALE       scale factor for instance geometries $-$ 1         SFHRINK       shrink percentage for instance geometries $-$ 1         STAVC       temperature exponent of ave2 $^{\circ}$ C <sup>-1</sup> 0         TTAVCX       temperature exponent of vef <td>PNJMAXI</td> <td>current at which to linearize diode currents</td> <td>A</td> <td>1</td>  | PNJMAXI   | current at which to linearize diode currents         | A                         | 1       |
| base charge model selection switch: $0$ =GP and $1$ =SGP — 0  QCO epi charge parameter C 0  QNIBETR ideal b-e quasi-neutral base recombination parameter — 0  QTF variation of tf with base-width modulation — 0  REBI intrinsic base resistance $\Omega$ 0  REBP parasitic transistor base resistance $\Omega$ 0  REBX extrinsic base resistance $\Omega$ 0  RECI intrinsic collector resistance $\Omega$ 0  RECX extrinsic emitter resistance $\Omega$ 0  RECX extrinsic substrate resistance $\Omega$ 0  RECX extrinsic substrate resistance $\Omega$ 0  RECX extrinsic substrate resistance $\Omega$ 0  RECX extrinsic emitter resistance $\Omega$ 0  RECX extrinsic substrate exponenties $\Omega$ 0  RECX extrinsic substrate resistance $\Omega$  | PNP       | pnp transistor type                                  | _                         | 0       |
| QCO       epi charge parameter       C       0         QNIBEIR       ideal b-c quasi-neutral base recombination parameter       —       0         QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RCX       extrinsic emitter resistance $\Omega$ 0         RE       extrinsic substrate resistance $\Omega$ 0         RE       extrinsic substrate resistance $\Omega$ 0         RETH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2 $^{\rm C}^{-1}$ 0         TCRTH       temperature exponent of rth $^{\rm C}^{\rm C}^{-1}$ 0         TCVEF       temperature exponent of ver <td>PS</td> <td>c-s built-in potential</td> <td>V</td> <td>0.75</td>  | PS        | c-s built-in potential                               | V                         | 0.75    |
| ONTBETR ideal b-e quasi-neutral base recombination parameter $-$ 0 OTF variation of tf with base-width modulation $-$ 0 OTF variation of tf with base-width modulation $-$ 0 OTF RBI intrinsic base resistance $-$ 0 OTF RBI parasitic transistor base resistance $-$ 0 OTF RBI parasitic collector resistance $-$ 0 OTF RBI parasitic collector resistance $-$ 0 OTF RBI parasitic collector resistance $-$ 0 OTF RBI parasitic substrate geometries $-$ 1 OTF RBI parasitic substrate geometries $-$ 1 OTF RBI parasitic substrate geometries $-$ 0 OTF RBI   | QBM       | base charge model selection switch: 0=GP and 1=SGP   |                           | 0       |
| QTF       variation of tf with base-width modulation       —       0         RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2       °C-1       0         TAVCX       temperature exponent of rth       °C-1       0         TCRTH       temperature exponent of vef       °C-1       0         TCVEF       temperature exponent of ver       °C-1       0         TCVER       temperature exponent of ver       °C-1       0         TF       forward transit time       s       0   | QCO       | epi charge parameter                                 | С                         | 0       |
| RBI       intrinsic base resistance $\Omega$ 0         RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic substrate resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance $-$ 0         SCALE       scale factor for instance geometries $-$ 1         SHRINK       shrink percentage for instance geometries $-$ 0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of vef $^{\circ}$ C <sup>-1</sup> 0         TCVEF       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TCVER       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TD       forward excess-phase delay time       s       0         TMAX       maximum ambient temperature  | QNIBEIR   | ideal b-e quasi-neutral base recombination parameter | _                         | 0       |
| RBP       parasitic transistor base resistance $\Omega$ 0         RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance $-$ 0         SCALE       scale factor for instance geometries $-$ 1         SHRINK       shrink percentage for instance geometries $-$ 0         TAVC       temperature exponent of avc2 $^{\circ}$ C <sup>-1</sup> 0         TAVCX       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0         TCRTH       temperature exponent of vef $^{\circ}$ C <sup>-1</sup> 0         TCVEF       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TCVER       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TD       forward excess-phase delay time       s       0         TMAX       maximum ambient temperature $^{\circ}$ C       500         TMAX       clip maximum temperature  | QTF       | variation of tf with base-width modulation           | _                         | 0       |
| RBX       extrinsic base resistance $\Omega$ 0         RCI       intrinsic collector resistance $\Omega$ 0         RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2       °C-1       0         TAVCX       temperature exponent of avc2       °C-1       0         TCRTH       temperature exponent of rth       °C-1       0         TCVEF       temperature exponent of ver       °C-1       0         TCVER       temperature exponent of ver       °C-1       0         TD       forward excess-phase delay time       s       0         TMAX       maximum ambient temperature       °C       500         TMAXCLIP       clip maximum temperature       °C       500  | RBI       | intrinsic base resistance                            | Ω                         | 0       |
| RCI intrinsic collector resistance $\Omega$ 0  RCX extrinsic collector resistance $\Omega$ 0  RE extrinsic emitter resistance $\Omega$ 0  RS extrinsic substrate resistance $\Omega$ 0  RTH thermal resistance geometries $\Omega$ 0  RTH thermal resistance geometries $\Omega$ 0  RTH thermal resistance geometries $\Omega$ 0  RTH temperature exponent of avc2 $\Omega$ $\Omega$ 0  RTH to $\Omega$ 1  RTH temperature exponent of avc2 $\Omega$ $\Omega$ 1  RTH temperature exponent of rh $\Omega$ $\Omega$ 1  RTH temperature exponent of rh $\Omega$ $\Omega$ 1  RTH temperature exponent of ver $\Omega$ $\Omega$ 1  RTH temperature exponent of ver $\Omega$ $\Omega$ 1  RTH temperature exponent of ver $\Omega$ $\Omega$ 1  RTH forward excess-phase delay time $\Omega$ 0  RTH forward transit time $\Omega$ 0  RTH forwar | RBP       | parasitic transistor base resistance                 | Ω                         | 0       |
| RCX       extrinsic collector resistance $\Omega$ 0         RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2       °C-1       0         TAVCX       temperature exponent of rth       °C-1       0         TCRTH       temperature exponent of vef       °C-1       0         TCVEF       temperature exponent of ver       °C-1       0         TCVER       temperature exponent of ver       °C-1       0         TD       forward excess-phase delay time       s       0         TF       forward transit time       s       0         TMAX       maximum ambient temperature       °C       500         TMAXCLIP       clip maximum temperature       °C       500         TMIN       minimum ambient temperature       °C       -100   | RBX       | extrinsic base resistance                            | Ω                         | 0       |
| RE       extrinsic emitter resistance $\Omega$ 0         RS       extrinsic substrate resistance $\Omega$ 0         RTH       thermal resistance       —       0         SCALE       scale factor for instance geometries       —       1         SHRINK       shrink percentage for instance geometries       —       0         TAVC       temperature exponent of avc2       °C-1       0         TAVCX       temperature exponent of avcx2       °C-1       0         TCRTH       temperature exponent of rth       °C-1       0         TCVEF       temperature exponent of ver       °C-1       0         TCVER       temperature exponent of ver       °C-1       0         TD       forward excess-phase delay time       s       0         TF       forward transit time       s       0         TMAX       maximum ambient temperature       °C       500         TMAXCLIP       clip maximum temperature       °C       500         TMIN       minimum ambient temperature       °C       -100   | RCI       | intrinsic collector resistance                       | Ω                         | 0       |
| extrinsic substrate resistance $\Omega$ 0  RTH thermal resistance — 0  SCALE scale factor for instance geometries — 1  SHRINK shrink percentage for instance geometries — 0  TAVC temperature exponent of avc2 °C <sup>-1</sup> 0  TAVCX temperature exponent of avc2 °C <sup>-1</sup> 0  TCRTH temperature exponent of rth °C <sup>-1</sup> 0  TCVEF temperature exponent of vef °C <sup>-1</sup> 0  TCVER temperature exponent of ver °C <sup>-1</sup> 0  TCVER temperature exponent of ver °C <sup>-1</sup> 0  TD forward excess-phase delay time s 0  TF forward transit time s 0  TMAX maximum ambient temperature °C 500  TMAXCLIP clip maximum temperature °C -100  | RCX       | extrinsic collector resistance                       | Ω                         | 0       |
| thermal resistance — 0  SCALE scale factor for instance geometries — 1  SHRINK shrink percentage for instance geometries — 0  TAVC temperature exponent of avc2 °C-1 0  TAVCX temperature exponent of avcx2 °C-1 0  TCRTH temperature exponent of rth °C-1 0  TCVEF temperature exponent of vef °C-1 0  TCVER temperature exponent of ver °C-1 0  TD forward excess-phase delay time s 0  TMAX maximum ambient temperature °C 500  TMAXCLIP clip maximum temperature °C 500  TMIN minimum ambient temperature °C -100  | RE        | extrinsic emitter resistance                         | Ω                         | 0       |
| scale factor for instance geometries — 1  SHRINK shrink percentage for instance geometries — 0  TAVC temperature exponent of avc2 °C <sup>-1</sup> 0  TAVCX temperature exponent of avcx2 °C <sup>-1</sup> 0  TCRTH temperature exponent of rth °C <sup>-1</sup> 0  TCVEF temperature exponent of vef °C <sup>-1</sup> 0  TCVER temperature exponent of ver °C <sup>-1</sup> 0  TCVER temperature exponent of ver °C <sup>-1</sup> 0  TD forward excess-phase delay time s 0  TF forward transit time s 0  TMAX maximum ambient temperature °C 500  TMAXCLIP clip maximum temperature °C 500  TMIN minimum ambient temperature °C -100   | RS        | extrinsic substrate resistance                       | Ω                         | 0       |
| SHRINK shrink percentage for instance geometries — 0  TAVC temperature exponent of avc2 °C <sup>-1</sup> 0  TAVCX temperature exponent of avcx2 °C <sup>-1</sup> 0  TCRTH temperature exponent of rth °C <sup>-1</sup> 0  TCVEF temperature exponent of vef °C <sup>-1</sup> 0  TCVER temperature exponent of ver °C <sup>-1</sup> 0  TD forward excess-phase delay time s 0  TF forward transit time s 0  TMAX maximum ambient temperature °C 500  TMAXCLIP clip maximum temperature °C 500  TMIN minimum ambient temperature °C -100   | RTH       | thermal resistance                                   | _                         | 0       |
| TAVC temperature exponent of avc2 $^{\circ}C^{-1}$ 0  TAVCX temperature exponent of avcx2 $^{\circ}C^{-1}$ 0  TCRTH temperature exponent of rth $^{\circ}C^{-1}$ 0  TCVEF temperature exponent of vef $^{\circ}C^{-1}$ 0  TCVER temperature exponent of ver $^{\circ}C^{-1}$ 0  TD forward excess-phase delay time s 0  TF forward transit time s 0  TMAX maximum ambient temperature $^{\circ}C$ 500  TMAXCLIP clip maximum temperature $^{\circ}C$ 500  TMIN minimum ambient temperature $^{\circ}C$ -100  | SCALE     | scale factor for instance geometries                 | _                         | 1       |
| TAVCX temperature exponent of avcx2 $^{\circ}$ C <sup>-1</sup> 0  TCRTH temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0  TCVEF temperature exponent of vef $^{\circ}$ C <sup>-1</sup> 0  TCVER temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0  TD forward excess-phase delay time s 0  TF forward transit time s 0  TMAX maximum ambient temperature $^{\circ}$ C 500  TMAXCLIP clip maximum temperature $^{\circ}$ C 500  TMIN minimum ambient temperature $^{\circ}$ C -100   | SHRINK    | shrink percentage for instance geometries            | _                         | 0       |
| TCRTH       temperature exponent of rth $^{\circ}$ C <sup>-1</sup> 0         TCVEF       temperature exponent of vef $^{\circ}$ C <sup>-1</sup> 0         TCVER       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TD       forward excess-phase delay time       s       0         TF       forward transit time       s       0         TMAX       maximum ambient temperature $^{\circ}$ C       500         TMAXCLIP       clip maximum temperature $^{\circ}$ C       500         TMIN       minimum ambient temperature $^{\circ}$ C       -100  | TAVC      | temperature exponent of avc2                         | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TCVEF       temperature exponent of vef $^{\circ}$ C <sup>-1</sup> 0         TCVER       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TD       forward excess-phase delay time       s       0         TF       forward transit time       s       0         TMAX       maximum ambient temperature $^{\circ}$ C       500         TMAXCLIP       clip maximum temperature $^{\circ}$ C       500         TMIN       minimum ambient temperature $^{\circ}$ C       -100   | TAVCX     | temperature exponent of avcx2                        | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TCVER       temperature exponent of ver $^{\circ}$ C <sup>-1</sup> 0         TD       forward excess-phase delay time       s       0         TF       forward transit time       s       0         TMAX       maximum ambient temperature $^{\circ}$ C       500         TMAXCLIP       clip maximum temperature $^{\circ}$ C       500         TMIN       minimum ambient temperature $^{\circ}$ C       -100  | TCRTH     | temperature exponent of rth                          | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| forward excess-phase delay time s 0  TF forward transit time s 0  TMAX maximum ambient temperature °C 500  TMAXCLIP clip maximum temperature °C 500  TMIN minimum ambient temperature °C -100  | TCVEF     | temperature exponent of vef                          | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| forward transit time s 0  TMAX maximum ambient temperature °C 500  TMAXCLIP clip maximum temperature °C 500  TMIN minimum ambient temperature °C -100  | TCVER     | temperature exponent of ver                          | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TMAX       maximum ambient temperature       °C       500         TMAXCLIP       clip maximum temperature       °C       500         TMIN       minimum ambient temperature       °C       -100  | TD        | forward excess-phase delay time                      | s                         | 0       |
| TMAXCLIP clip maximum temperature °C 500  TMIN minimum ambient temperature °C -100   | TF        | forward transit time                                 | S                         | 0       |
| TMIN minimum ambient temperature °C -100   | TMAX      | maximum ambient temperature                          | °C                        | 500     |
| 1  | TMAXCLIP  | clip maximum temperature                             | °C                        | 500     |
| TMINCLIP clip minimum temperature °C -100  |           | • •  | °C                        | -100    |
|  | TMINCLIP  |  | °C                        | -100    |

Table 2-70. VBIC 1.3 4T Device Model Parameters

| Parameter | Description  | Units                     | Default |
|-----------|--|---------------------------|---------|
| TNBBE     | temperature coefficient of nbbe                              | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TNF       | temperature exponent of nf and nr                            | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TNOM      | nominal (reference) temperature                              | °C                        | 27      |
| TR        | reverse transit time   | S                         | 0       |
| TVBBE1    | linear temperature coefficient of vbbe                       | $^{\circ}\mathrm{C}^{-1}$ | 0       |
| TVBBE2    | quadratic temperature coefficient of vbbe                    | _                         | 0       |
| TYPE      | transistor type: -1=npn and +1=pnp (overriden by npn or pnp) | _                         | -1      |
| VBBE      | b-e breakdown voltage  | V                         | 0       |
| VEF       | forward Early voltage (zero=infinite)                        | V                         | 0       |
| VER       | reverse Early voltage (zero=infinite)                        | V                         | 0       |
| VO        | epi drift saturation voltage                                 | V                         | 0       |
| VPTE      | SiGe base current kink voltage                               | V                         | 0       |
| VRT       | reach-through voltage for Cbc limiting                       | V                         | 0       |
| VTF       | tf coefficient of Vbci dependence                            | V                         | 0       |
| WBE       | partitioning of Ibe/Ibex and Qbe/Qbex                        |                           | 1       |
| WSP       | partitioning of Iccp between Vbep and Vbci                   | _                         | 1       |
| XII       | temperature exponent of ibei, ibci, ibeip, ibcip             | _                         | 3       |
| XIKF      | temperature exponent of ikf                                  | _                         | 0       |
| XIN       | temperature exponent of iben, iben, ibenp, ibenp             | _                         | 3       |
| XIS       | temperature exponent of is                                   | _                         | 3       |
| XISR      | temperature exponent for isrr                                | _                         | 0       |
| XRB       | temperature exponent of rbx and rbi                          | _                         | 0       |
| XRBI      | temperature exponent of rbi (overrides xrb)                  | _                         | 0       |
| XRBP      | temperature exponent of rbp (overrides xrc)                  | _                         | 0       |
| XRBX      | temperature exponent of rbx (overrides xrb)                  | _                         | 0       |
| XRC       | temperature exponent of rci and rcx and rbp                  | _                         | 0       |
| XRCI      | temperature exponent of rci (overrides xrc)                  | _                         | 0       |
| XRCX      | temperature exponent of rcx (overrides xrc)                  |                           | 0       |
| XRE       | temperature exponent of re                                   | _                         | 0       |
| XRS       | temperature exponent of rs                                   | _                         | 0       |
| XTF       | tf bias dependence coefficient                               | _                         | 0       |
| XVO       | temperature exponent of vo                                   | _                         | 0       |

# 2.3.17.5. Level 23 BJT Tables (FBH HBT\_X)

Table 2-71. FBH HBT\_X v2.1 Device Instance Parameters

| Parameter | Description                  | Units | Default |
|-----------|------------------------------|-------|---------|
| L         | Length of emitter fingers    | m     | 3e-05   |
| N         | Number of emitter fingers    | -     | 1       |
| TEMP      | Device operating temperature | °C    | 25      |
| W         | Width of emitter fingers     | m     | 3e-06   |

Table 2-72. FBH HBT\_X v2.1 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| AHC       |             | -     | 0       |
| BF        |             | _     | 100     |
| BR        |             | _     | 1       |
| BVCEO     |             | _     | 0       |
| BVEBO     |             | _     | 0       |
| CJC       |             | _     | 1e-15   |
| CJE       |             | -     | 1e-15   |
| CMIN      |             | -     | 1e-16   |
| СРВ       |             | _     | 0       |
| CPC       |             | _     | 0       |
| CQ        |             | -     | 0       |
| СТН       |             | _     | 7e-07   |
| DEBUG     |             | _     | 0       |
| DEBUGPLUS |             | _     | 0       |
| IKF       |             | -     | 0       |
| IKR       |             | _     | 0       |
| Ј0        |             | -     | 0.001   |
| JK        |             | _     | 0.0004  |
| JSC       |             | _     | 0       |
| JSE       |             | -     | 0       |
| JSEE      |             | _     | 0       |
| JSF       |             | _     | 2e-23   |
| JSR       |             | _     | 2e-17   |
| KBETA     |             | _     | 0       |
| KC        |             | _     | 0       |
| KJC       |             | _     | 1       |

Table 2-72. FBH HBT\_X v2.1 Device Model Parameters

| Parameter | Description                  | Units | Default |
|-----------|------------------------------|-------|---------|
| L         | Length of emitter fingers    | m     | 3e-05   |
| LB        |                              | _     | 0       |
| LC        |                              | _     | 0       |
| LE        |                              | _     | 0       |
| MC        |                              | _     | 0       |
| MJC       |                              | _     | 0.5     |
| MJE       |                              | _     | 0.5     |
| MODE      |                              | _     | 1       |
| N         | Number of emitter fingers    | _     | 1       |
| NC        |                              | _     | 0       |
| NE        |                              | _     | 0       |
| NEE       |                              | _     | 0       |
| NF        |                              | -     | 1       |
| NOISE     |                              | -     | 1       |
| NR        |                              | -     | 1       |
| RB        |                              | _     | 1       |
| RB2       |                              | _     | 1       |
| RBBXX     |                              | _     | 1e+06   |
| RBXX      |                              | -     | 1e+06   |
| RC        |                              | _     | 1       |
| RCI0      |                              | _     | 0.001   |
| RCXX      |                              | _     | 1e+06   |
| RE        |                              | _     | 1       |
| RJK       |                              | _     | 0.001   |
| RTH       |                              | _     | 0.1     |
| TEMP      | Device operating temperature | °C    | 25      |
| ΓF        |                              | _     | 1e-12   |
| IFT       |                              | _     | 0       |
| THCS      |                              | _     | 0       |
| TNOM      |                              | _     | 20      |
| TR        |                              | _     | 1e-15   |
| TRX       |                              | _     | 1e-15   |
| VAF       |                              | _     | 0       |
| VAR       |                              | _     | 0       |
| VCES      |                              | _     | 0.001   |
| VG        |                              | _     | 1.3     |

Table 2-72. FBH HBT\_X v2.1 Device Model Parameters

| Parameter | Description              | Units | Default |
|-----------|--------------------------|-------|---------|
| VGB       |                          | _     | 0       |
| VGBB      |                          | _     | 0       |
| VGC       |                          | _     | 0       |
| VGR       |                          | _     | 0       |
| VJC       |                          | -     | 1.3     |
| VJE       |                          | _     | 1.3     |
| W         | Width of emitter fingers | m     | 3e-06   |
| XCJC      |                          | _     | 0.5     |
| XJ0       |                          | _     | 1       |

## 2.3.17.6. Level 230 BJT Tables (HICUM/L0)

The HICUM/L0 device supports output of the internal variables in table 2-75 on the .PRINT line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific HICUM/L0 Q device in your netlist.

Table 2-73. HICUM L0 v1.32 Device Instance Parameters

| Parameter | Description                                  | Units | Default |
|-----------|--|-------|---------|
| DT        | Temperature change for particular transistor | _     | 0       |

#### Table 2-74. HICUM L0 v1.32 Device Model Parameters

| Parameter | Description   | Units | Default          |
|-----------|---|-------|------------------|
| AF        | flicker noise exponent factor   | _     | 2                |
| AHC       | Smoothing facor for current dependence  | _     | 0.1              |
| AHQ       | Smoothing factor for the d.c. injection width                                   | _     | 0                |
| AJE       | Ratio of maximum to zero-bias value   | _     | 2.5              |
| AJEDC     | BE capacitance ratio Ratio maximum to zero-bias value for d.c. transfer current | -     | 2.5              |
| ALCES     | Relative TC of vces   | _     | 0                |
| ALEAV     | TC of avalanche exponential factor  | _     | 0                |
| ALIQFH    | Frist-order TC of iqfh  | _     | 0                |
| ALIT      | Factor for additional delay time of transfer current                            | _     | 0.333            |
| ALKAV     | TC of avalanche prefactor   | _     | 0                |
| ALQF      | Factor for additional delay time of minority charge                             | _     | 0.167            |
| ALT0      | Frist-order TC of tf0   | _     | 0                |
| ALVS      | Relative TC of satur.drift velocity   | _     | 0                |
| AVER      | bias dependence for reverse Early voltage                                       | _     | 0                |
| CBCPAR    | Collector-base isolation (overlap) capacitance                                  | _     | 0                |
| CBEPAR    | Emitter-base oxide capacitance  | _     | 0                |
| CJCI0     | Total zero-bias BC depletion capacitance  | _     | 1e-20            |
| CJCX0     | Zero-bias external BC depletion capacitance                                     | _     | 1e-20            |
| CJE0      | Zero-bias BE depletion capacitance  | _     | 1e-20            |
| CJS0      | Zero-bias SC depletion capacitance  | _     | 1e-20            |
| СТН       | Thermal capacitance   | _     | 0                |
| DTOH      |   | _     | 0                |
| DVGBE     | Bandgap difference between base and BE-junction                                 | _     | 0                |
| EAVL      | Exponent factor   | _     | 0                |
| F1VG      | Coefficient K1 in T-dependent bandgap equation                                  | _     | -<br>0.000102377 |

Table 2-74. HICUM L0 v1.32 Device Model Parameters

| Parameter | Description   | Units | Default    |
|-----------|---|-------|------------|
| F2VG      | Coefficient K2 in T-dependent bandgap equation            | _     | 0.00043215 |
| FBC       | Split factor = Cjci0/Cjc0                                 | _     | 1          |
| FGEO      | Geometry factor   | _     | 0.656      |
| FIQF      | flag for turning on base related critical current         | _     | 0          |
| FLNQS     | Flag for turning on and off of vertical NQS effect        | _     | 0          |
| FLSH      | Flag for self-heating calculation                         | _     | 0          |
| GTE       | Exponent factor for emmiter transit time                  | _     | 1          |
| IBCS      | BC saturation current                                     | _     | 0          |
| IBES      | BE saturation current                                     | _     | 1e-18      |
| IQF       | forward d.c. high-injection toll-off current              | _     | 1e+06      |
| IQFH      | high-injection correction current                         | _     | 1e+06      |
| IQR       | inverse d.c. high-injection roll-off current              | _     | 1e+06      |
| IRES      | BE recombination saturation current                       | _     | 0          |
| IS        | (Modified) saturation current                             | _     | 1e-16      |
| ISCS      | SC saturation current                                     | _     | 0          |
| IT_MOD    | Flag for using third order solution for transfer current  | _     | 0          |
| ITSS      | Substrate transistor transfer saturation current          | _     | 0          |
| KAVL      | Prefactor   | _     | 0          |
| KF        | flicker noise coefficient                                 | _     | 0          |
| KIQFH     | Second-order TC of iqfh                                   | _     | 0          |
| KT0       | Second-order TC of tf0                                    | _     | 0          |
| MBC       | BC non-ideality factor                                    | _     | 1          |
| MBE       | BE non-ideality factor                                    | _     | 1          |
| MCF       | Non-ideality coefficient of forward collector current     | _     | 1          |
| MCR       | Non-ideality coefficient of reverse collector current     | _     | 1          |
| MRE       | BE recombination non-ideality factor                      | _     | 2          |
| MSC       | SC non-ideality factor                                    | _     | 1          |
| MSF       | Substrate transistor transfer current non-ideality factor | _     | 1          |
| RBI0      | Internal base resistance at zero-bias                     | _     | 0          |
| RBX       | External base series resistance                           | _     | 0          |
| RCI0      | Low-field collector resistance under emitter              | _     | 150        |
| RCX       | Emitter series resistance                                 | _     | 0          |
| RE        | External collector series resistance                      | _     | 0          |
| RTH       | Thermal resistance  | _     | 0          |
| TO        | low current transit time at Vbici=0                       | _     | 0          |
| TBVL      | SCR width modulation contribution                         | _     | 0          |

Table 2-74. HICUM L0 v1.32 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| TEF0      | Storage time in neutral emitter                                    | _     | 0       |
| TEF_TEMP  | Flag for turning temperature dependence of tef0 on and off         | -     | 1       |
| TFH       | high-injection correction factor                                   | -     | 0       |
| THCS      | Saturation time at high current densities                          | _     | 0       |
| TNOM      | Temperature for which parameters are valid                         | _     | 27      |
| TR        | Storage time at inverse operation                                  | _     | 0       |
| TYPE      | For transistor type NPN(+1) or PNP (-1)                            | _     | 1       |
| VCES      | Saturation voltage   | _     | 0.1     |
| VDCI      | BC built-in voltage  | _     | 0.7     |
| VDCX      | External BC built-in voltage                                       | _     | 0.7     |
| VDE       | BE built-in voltage  | _     | 0.9     |
| VDEDC     | BE charge built-in voltage for d.c. transfer current               | _     | 0.9     |
| VDS       | SC built-in voltage  | _     | 0.3     |
| VEF       | forward Early voltage (normalization volt.)                        | _     | 1e+06   |
| VER       | reverse Early voltage (normalization volt.)                        | _     | 1e+06   |
| VGB       | Bandgap-voltage  | _     | 1.2     |
| VGC       | Effective collector bandgap-voltage                                | -     | 1.17    |
| VGE       | Effective emitter bandgap-voltage                                  | _     | 1.17    |
| VGS       | Effective substrate bandgap-voltage                                | _     | 1.17    |
| VLIM      | Voltage dividing ohmic and satur.region                            | _     | 0.5     |
| VPT       | Punch-through voltage  | _     | 100     |
| VPTCI     | Punch-through voltage of BC junction                               | _     | 100     |
| VPTCX     | Punch-through voltage  | _     | 100     |
| VPTS      | SC punch-through voltage   | _     | 100     |
| VR0C      | forward Early voltage (normalization volt.)                        | -     | 1e+06   |
| VR0E      | forward Early voltage (normalization volt.)                        | _     | 2.5     |
| ZCI       | BC exponent factor   | _     | 0.333   |
| ZCX       | External BC exponent factor  | _     | 0.333   |
| ZE        | BE exponent factor   | _     | 0.5     |
| ZEDC      | charge BE exponent factor for d.c. transfer current                | -     | 0.5     |
| ZETABET   | Exponent coefficient in BE junction current temperature dependence | -     | 3.5     |
| ZETACI    | TC of epi-collector diffusivity                                    | _     | 0       |
| ZETACT    | Exponent coefficient in transfer current temperature dependence    | -     | 3       |
| ZETAIQF   | TC of iqf  | _     | 0       |

Table 2-74. HICUM L0 v1.32 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| ZETARBI   | TC of internal base resistance                               | _     | 0       |
| ZETARBX   | TC of external base resistance                               | _     | 0       |
| ZETARCX   | TC of external collector resistance                          | _     | 0       |
| ZETARE    | TC of emitter resistances                                    | _     | 0       |
| ZETARTH   | Exponent factor for temperature dependent thermal resistance | _     | 0       |
| ZETAVER   | TC of Reverse Early voltage                                  | _     | -1      |
| ZETAVGBE  | TC of AVER   | _     | 1       |
| ZS        | External SC exponent factor                                  | -     | 0.3     |

Table 2-75. BJT level 230 Output Variables

| Parameter | Description  | Units         | Default |
|-----------|--|---------------|---------|
| qjci      | B-C internal junction charge                             | С             | none    |
| qjei      | B-E internal junction charge                             | С             | none    |
| it        | Transfer Current   | A             | none    |
| ijbc      | Base-collector diode current                             | A             | none    |
| iavl      | Avalanche current  | A             | none    |
| ijsc      | Substrate-collector diode current                        | A             | none    |
| Ibici     | Base-collector diode current minus the avalanche current | A             | none    |
| ijbe      | Base-emitter diode current                               | A             | none    |
| IAVL      | Avalanche current  | A             | none    |
| VBE       | External BE voltage                                      | V             | none    |
| VBC       | External BC voltage                                      | V             | none    |
| VCE       | External CE voltage                                      | V             | none    |
| VSC       | External SC voltage                                      | V             | none    |
| GMi       | Internal transconductance                                | $\Omega^{-1}$ | none    |
| RPIi      | Internal input resistance                                | Ohm           | none    |
| RMUi      | Internal feedback resistance                             | Ohm           | none    |
| ROi       | Internal Output resistance                               | Ohm           | none    |
| CPIi      | Total BE capacitance                                     | F             | none    |
| CMUi      | Total internal BC capacitance                            | F             | none    |
| CBCX      | Total external BC capacitance                            | F             | none    |
| CCS       | CS junction capacitance                                  | F             | none    |
| RBi       | Internal base resistance                                 | Ohm           | none    |
| RB        | Total base resistance                                    | Ohm           | none    |

Table 2-75. BJT level 230 Output Variables

| Parameter | Description                                      | Units | Default |
|-----------|--|-------|---------|
| RCX       | External (saturated) collector series resistance | Ohm   | none    |
| RE        | Emitter series resistance                        | Ohm   | none    |
| BETAAC    | Small signal current gain                        | _     | none    |
| TF        | Total forward transit time                       | S     | none    |
| FT        | Transit frequency                                | Hz    | none    |

## 2.3.17.7. Level 234 BJT Table (HICUM/L2)

**NOTE:** The HICUM/L2 model has no instance parameters. The HICUM/L2 device supports output of the internal variables in table 2-77 on the .PRINT line of a netlist. To access them from a print line, use the syntax  $\mathbb{N}$  (<instance>:<variable>) where "<instance>" refers to the name of the specific HICUM/L2 Q device in your netlist.

Table 2-76. HICUM v2.4.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| ABET      | Exponent factor for tunneling current                                      | _     | 40      |
| ACBAR     | Smoothing parameter for barrier voltage                                    | _     | 0.01    |
| AF        | Flicker noise exponent factor  | _     | 2       |
| AFRE      | Emitter resistance flicker noise exponent factor                           | _     | 2       |
| AHC       | Smoothing factor for current dependence of base and collector transit time | _     | 0.1     |
| AHJEI     | Parameter describing the slope of hjEi(VBE)                                | _     | 0       |
| AICK      | Smoothing term for ICK   | _     | 0.001   |
| AJEI      | Ratio of maximum to zero-bias value of internal B-E capacitance            | -     | 2.5     |
| AJEP      | Ratio of maximum to zero-bias value of peripheral B-E capacitance          | _     | 2.5     |
| ALB       | Relative TC of forward current gain for V2.1 model                         | -     | 0       |
| ALCES     | Relative TC of VCES  | _     | 0       |
| ALFAV     | Relative TC for FAVL   | _     | 0       |
| ALIT      | Factor for additional delay time of transfer current                       | _     | 0.333   |
| ALKAV     | Relative TC for KAVL   | _     | 0       |
| ALQAV     | Relative TC for QAVL   | _     | 0       |
| ALQF      | Factor for additional delay time of minority charge                        | _     | 0.167   |
| ALRTH     | First order relative TC of parameter Rth                                   | _     | 0       |
| ALT0      | First order relative TC of parameter T0                                    | _     | 0       |
| ALVS      | Relative TC of saturation drift velocity                                   | _     | 0       |
| C10       | GICCR constant   | _     | 2e-30   |
| CBCPAR    | Total parasitic B-C capacitance  | _     | 0       |
| CBEPAR    | Total parasitic B-E capacitance  | _     | 0       |
| CFBE      | Flag for determining where to tag the flicker noise source                 | _     | -1      |
| CJCI0     | Internal B-C zero-bias depletion capacitance                               | _     | 1e-20   |
| CJCX0     | External B-C zero-bias depletion capacitance                               | _     | 1e-20   |
| CJEI0     | Internal B-E zero-bias depletion capacitance                               | _     | 1e-20   |
| CJEP0     | Peripheral B-E zero-bias depletion capacitance                             | _     | 1e-20   |
| CJS0      | C-S zero-bias depletion capacitance  | _     | 0       |

Table 2-76. HICUM v2.4.0 Device Model Parameters

| Parameter | Description  | Units | Default     |
|-----------|--|-------|-------------|
| CSCP0     | Perimeter S-C zero-bias depletion capacitance                          | _     | 0           |
| CSU       | Substrate shunt capacitance  | _     | 0           |
| CTH       | Thermal capacitance  | _     | 0           |
| DELCK     | Fitting factor for critical current                                    | _     | 2           |
| DT        | Temperature change w.r.t. chip temperature for particular transistor   | -     | 0           |
| DT0H      | Time constant for base and B-C space charge layer width modulation     | _     | 0           |
| DVGBE     | Bandgap difference between B and B-E junction used for hjEi0 and hf0   | -     | 0           |
| F1VG      | Coefficient K1 in T-dependent band-gap equation                        | _     | 0.000102377 |
| F2VG      | Coefficient K2 in T-dependent band-gap equation                        | _     | 0.00043215  |
| FAVL      | Avalanche current factor   | _     | 0           |
| FBCPAR    | Partitioning factor of parasitic B-C cap                               | _     | 0           |
| FBEPAR    | Partitioning factor of parasitic B-E cap                               | _     | 1           |
| FCRBI     | Ratio of HF shunt to total internal capacitance (lateral NQS effect)   | _     | 0           |
| FDQR0     | Correction factor for modulation by B-E and B-C space charge layer     | _     | 0           |
| FGEO      | Factor for geometry dependence of emitter current crowding             | _     | 0.6557      |
| FLCOMP    | Flag for compatibility with v2.1 model (0=v2.1)                        | _     | 0           |
| FLCONO    | Flag for turning on and off of correlated noise implementation         | -     | 0           |
| FLNQS     | Flag for turning on and off of vertical NQS effect                     | _     | 0           |
| FLSH      | Flag for turning on and off self-heating effect                        | _     | 0           |
| FQI       | Ration of internal to total minority charge                            | _     | 1           |
| FTHC      | Partitioning factor for base and collector portion                     | _     | 0           |
| GTFE      | Exponent factor for current dependence of neutral emitter storage time | -     | 1           |
| HF0       | Weight factor for the low current minority charge                      | _     | 1           |
| HFC       | Collector minority charge weighting factor in HBTs                     | _     | 1           |
| HFE       | Emitter minority charge weighting factor in HBTs                       | _     | 1           |
| HJCI      | B-C depletion charge weighting factor in HBTs                          | _     | 1           |
| HJEI      | B-E depletion charge weighting factor in HBTs                          | _     | 1           |
| IBCIS     | Internal B-C saturation current  | _     | 1e-16       |
| IBCXS     | External B-C saturation current  | _     | 0           |

Table 2-76. HICUM v2.4.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| IBEIS     | Internal B-E saturation current   | _     | 1e-18   |
| IBEPS     | Peripheral B-E saturation current   | _     | 0       |
| IBETS     | B-E tunneling saturation current  | _     | 0       |
| ICBAR     | Normalization parameter   | _     | 0       |
| ICH       | High-current correction for 2D and 3D effects                               | _     | 0       |
| IREIS     | Internal B-E recombination saturation current                               | _     | 0       |
| IREPS     | Peripheral B-E recombination saturation current                             | _     | 0       |
| ISCS      | C-S diode saturation current  | _     | 0       |
| ITSS      | Substrate transistor transfer saturation current                            | _     | 0       |
| KAVL      | Flag/factor for turning strong avalanche on                                 | _     | 0       |
| KF        | Flicker noise coefficient   | _     | 0       |
| KFRE      | Emitter resistance flicker noise coefficient                                | _     | 0       |
| KT0       | Second order relative TC of parameter T0                                    | _     | 0       |
| LATB      | Scaling factor for collector minority charge in direction of emitter width  | _     | 0       |
| LATL      | Scaling factor for collector minority charge in direction of emitter length | -     | 0       |
| MBCI      | Internal B-C current ideality factor  | _     | 1       |
| MBCX      | External B-C current ideality factor  | _     | 1       |
| MBEI      | Internal B-E current ideality factor  | _     | 1       |
| MBEP      | Peripheral B-E current ideality factor                                      | _     | 1       |
| MCF       | Non-ideality factor for III-V HBTs  | _     | 1       |
| MREI      | Internal B-E recombination current ideality factor                          | _     | 2       |
| MREP      | Peripheral B-E recombination current ideality factor                        | _     | 2       |
| MSC       | Ideality factor of C-S diode current  | _     | 1       |
| MSF       | Forward ideality factor of substrate transfer current                       | _     | 1       |
| QAVL      | Exponent factor for avalanche current                                       | _     | 0       |
| QP0       | Zero-bias hole charge   | _     | 2e-14   |
| RBI0      | Zero bias internal base resistance  | _     | 0       |
| RBX       | External base series resistance   | _     | 0       |
| RCI0      | Internal collector resistance at low electric field                         | _     | 150     |
| RCX       | External collector series resistance  | _     | 0       |
| RE        | Emitter series resistance   | _     | 0       |
| RHJEI     | Smoothing parameter for hjEi(VBE) at high voltage                           | _     | 1       |
| RSU       | Substrate series resistance   | _     | 0       |
| RTH       | Thermal resistance  | _     | 0       |

Table 2-76. HICUM v2.4.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| TO        | Low current forward transit time at VBC=0V   | _     | 0       |
| TBHREC    | Base current recombination time constant at B-C barrier for high forward injection | _     | 0       |
| TBVL      | Time constant for modeling carrier jam at low VCE                                  | _     | 0       |
| TEF0      | Neutral emitter storage time   | _     | 0       |
| THCS      | Saturation time constant at high current densities                                 | _     | 0       |
| TNOM      | Temperature at which parameters are specified                                      | _     | 27      |
| TR        | Storage time for inverse operation   | _     | 0       |
| TSF       | Transit time for forward operation of substrate transistor                         | _     | 0       |
| TUNODE    | Specifies the base node connection for the tunneling current                       | _     | 1       |
| TYPE      | For transistor type NPN(+1) or PNP (-1)  | _     | 1       |
| VCBAR     | Barrier voltage  |       | 0       |
| VCES      | Internal C-E saturation voltage  | _     | 0.1     |
| VDCI      | Internal B-C built-in potential  | _     | 0.7     |
| VDCX      | External B-C built-in potential  | _     | 0.7     |
| VDEI      | Internal B-E built-in potential  | -     | 0.9     |
| VDEP      | Peripheral B-E built-in potential  | _     | 0.9     |
| VDS       | C-S built-in potential   | -     | 0.6     |
| VDSP      | Perimeter S-C built-in potential   | _     | 0.6     |
| VGB       | Bandgap voltage extrapolated to 0 K  | _     | 1.17    |
| VGC       | Effective collector bandgap voltage  | -     | 1.17    |
| VGE       | Effective emitter bandgap voltage  | _     | 1.17    |
| VGS       | Effective substrate bandgap voltage  | _     | 1.17    |
| VLIM      | Voltage separating ohmic and saturation velocity regime                            | _     | 0.5     |
| VPT       | Collector punch-through voltage  | _     | 100     |
| VPTCI     | Internal B-C punch-through voltage   |       | 100     |
| VPTCX     | External B-C punch-through voltage   | _     | 100     |
| VPTS      | C-S punch-through voltage  | _     | 100     |
| VPTSP     | Perimeter S-C punch-through voltage  | _     | 100     |
| ZCI       | Internal B-C grading coefficient   | _     | 0.4     |
| ZCX       | External B-C grading coefficient   | _     | 0.4     |
| ZEI       | Internal B-E grading coefficient   |       | 0.5     |
| ZEP       | Peripheral B-E grading coefficient   | _     | 0.5     |

Table 2-76. HICUM v2.4.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| ZETABET   | Exponent coefficient in B-E junction current temperature dependence   | _     | 3.5     |
| ZETACI    | Temperature exponent for RCI0   | -     | 0       |
| ZETACT    | Exponent coefficient in transfer current temperature dependence       | _     | 3       |
| ZETACX    | Temperature exponent of mobility in substrate transistor transit time | _     | 1       |
| ZETAHJEI  | Temperature coefficient for ahjEi                                     | _     | 1       |
| ZETARBI   | Temperature exponent of internal base resistance                      | _     | 0       |
| ZETARBX   | Temperature exponent of external base resistance                      | _     | 0       |
| ZETARCX   | Temperature exponent of external collector resistance                 | _     | 0       |
| ZETARE    | Temperature exponent of emitter resistance                            | _     | 0       |
| ZETARTH   | Temperature coefficient for Rth                                       | _     | 0       |
| ZETAVGBE  | Temperature coefficient for hjEi0                                     | _     | 1       |
| ZS        | C-S grading coefficient   | _     | 0.5     |
| ZSP       | Perimeter S-C grading coefficient                                     | _     | 0.5     |

Table 2-77. BJT level 234 Output Variables

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| rcx_t     | External (saturated) collector series resistance    | Ohm   | none    |
| re_t      | Emitter series resistance                           | Ohm   | none    |
| rbi       | Internal base resistance as calculated in the model | Ohm   | none    |
| rb        | Total base resistance as calculated in the model    | Ohm   | none    |
| IAVL      | Avalanche current                                   | A     | none    |
| VBE       | External BE voltage                                 | V     | none    |
| VBC       | External BC voltage                                 | V     | none    |
| VCE       | External CE voltage                                 | V     | none    |
| VSC       | External SC voltage                                 | V     | none    |
| GMi       | Internal transconductance                           | A/V   | none    |
| GMS       | Transconductance of the parasitic substrate PNP     | A/V   | none    |
| RPIi      | Internal base-emitter (input) resistance            | Ohm   | none    |
| RPIx      | External base-emitter (input) resistance            | Ohm   | none    |
| RMUi      | Internal feedback resistance                        | Ohm   | none    |
| RMUx      | External feedback resistance                        | Ohm   | none    |
| ROi       | Output resistance                                   | Ohm   | none    |
| CPIi      | Total internal BE capacitance                       | F     | none    |

Table 2-77. BJT level 234 Output Variables

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| CPIx      | Total external BE capacitance                           | F     | none    |
| CMUi      | Total internal BC capacitance                           | F     | none    |
| CMUx      | Total external BC capacitance                           | F     | none    |
| CCS       | CS junction capacitance                                 | F     | none    |
| BETAAC    | Small signal current gain                               | _     | none    |
| CRBI      | Shunt capacitance across RBI as calculated in the model | F     | none    |
| TF        | Forward transit time                                    | S     | none    |
| FT        | Transit frequency                                       | Hz    | none    |
| TK        | Actual device temperature                               | K     | none    |
| DTSH      | Temperature increase due to self-heating                | K     | none    |

## 2.3.17.8. Level 504 and 505 BJT Tables (MEXTRAM)

The MEXTRAM device supports output of the internal variables in tables 2-80 and 2-80 on the <code>.PRINT</code> line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific MEXTRAM Q device in your netlist.

Table 2-78. MEXTRAM 504.12.1 Device Instance Parameters

| Parameter | Description           | Units | Default |
|-----------|-----------------------|-------|---------|
| М         | Alias for MULT        | _     | 1       |
| MULT      | Multiplication factor | _     | 1       |

Table 2-79. MEXTRAM 504.12.1 Device Model Parameters

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| AB        | Temperature coefficient of the resistivity of the base                          | _     | 1        |
| AC        | Temperature coefficient of the resistivity of the collector contact             |       | 2        |
| ACBL      | Temperature coefficient of the resistivity of the collector buried layer        | _     | 2        |
| AE        | Temperature coefficient of the resistivity of the emitter                       | _     | 0        |
| AEPI      | Temperature coefficient of the resistivity of the epilayer                      |       | 2.5      |
| AEX       | Temperature coefficient of the resistivity of the extrinsic base                | _     | 0.62     |
| AF        | Exponent of the Flicker-noise   | _     | 2        |
| AQBO      | Temperature coefficient of the zero-bias base charge                            | _     | 0.3      |
| AS        | Substrate temperature coefficient   | _     | 1.58     |
| ASUB      | Temperature coefficient for mobility of minorities in the substrate             | _     | 2        |
| AVGEB     | Temperature coefficient band-gap voltage for Zener effect emitter-base junction | _     | 0.000473 |
| AXI       | Smoothness parameter for the onset of quasi-saturation                          | _     | 0.3      |
| BF        | Ideal forward current gain  | _     | 215      |
| BRI       | Ideal reverse current gain  | _     | 7        |
| CBCO      | Collector-base overlap capacitance  | _     | 0        |
| CBEO      | Emitter-base overlap capacitance  | _     | 0        |
| CJC       | Zero-bias collector-base depletion capacitance                                  | _     | 7.8e-14  |
| CJE       | Zero-bias emitter-base depletion capacitance                                    | _     | 7.3e-14  |
| CJS       | Zero-bias collector-substrate depletion capacitance                             | _     | 3.15e-13 |

Table 2-79. MEXTRAM 504.12.1 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| DAIS      | Fine tuning of temperature dependence of C-E saturation current | _     | 0       |
| DEG       | Bandgap difference over the base                                | _     | 0       |
| DTA       | Difference between the local and global ambient temperatures    | _     | 0       |
| DVGBF     | Band-gap voltage difference of the forward current gain         | _     | 0.05    |
| DVGBR     | Band-gap voltage difference of the reverse current gain         | _     | 0.045   |
| DVGTE     | Band-gap voltage difference of emitter stored charge            |       | 0.05    |
| EXAVL     | Flag for extended modeling of avalanche currents                | _     | 0       |
| EXMOD     | Flag for extended modeling of the reverse current gain          |       | 1       |
| EXPHI     | Flag for the distributed high-frequency effects in transient    |       | 1       |
| EXSUB     | Flag for extended modelling of substrate currents               | _     | 0       |
| FTAUN     | Fraction of noise transit time to total transit time            | _     | 0       |
| GMIN      | Minimum conductance   |       | 1e-13   |
| IBF       | Saturation current of the non-ideal forward base current        | _     | 2.7e-15 |
| IBR       | Saturation current of the non-ideal reverse base current        | _     | 1e-15   |
| ICSS      | Collector-substrate ideal saturation current                    |       | -1      |
| IHC       | Critical current for velocity saturation in the epilayer        | _     | 0.004   |
| IK        | Collector-emitter high injection knee current                   | _     | 0.1     |
| IKS       | Base-substrate high injection knee current                      | _     | 0.00025 |
| IS        | Collector-emitter saturation current                            | _     | 2.2e-17 |
| ISS       | Base-substrate saturation current                               | _     | 4.8e-17 |
| IZEB      | Pre-factor of emitter-base Zener tunneling current              | _     | 0       |
| KAVL      | Switch for white noise contribution due to avalanche            | _     | 0       |
| KC        | Switch for RF correlation noise model selection                 | _     | 0       |
| KE        | Fraction of QE in excess phase shift                            | _     | 0       |
| KF        | Flicker-noise coefficient of the ideal base current             | _     | 2e-11   |
| KFN       | Flicker-noise coefficient of the non-ideal base current         | _     | 2e-11   |
| LEVEL     | Model level   | _     | 504     |
| M         | Alias for MULT  | _     | 1       |
| MC        | Coefficient for current modulation of CB depletion capacitance  | _     | 0.5     |

Table 2-79. MEXTRAM 504.12.1 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| MLF       | Non-ideality factor of the non-ideal forward base current                       | _     | 2       |
| MTAU      | Non-ideality factor of the emitter stored charge                                | _     | 1       |
| MULT      | Multiplication factor   | _     | 1       |
| NZEB      | Coefficient of emitter-base Zener tunneling current                             | _     | 22      |
| PC        | Collector-base grading coefficient  | _     | 0.5     |
| PE        | Emitter-base grading coefficient  | _     | 0.4     |
| PS        | Collector-substrate grading coefficient   | _     | 0.34    |
| RBC       | Constant part of the base resistance  | _     | 23      |
| RBV       | Zero-bias value of the variable part of the base resistance                     | _     | 18      |
| RCBLI     | Resistance Collector Buried Layer Intrinsic                                     | _     | 0       |
| RCBLX     | Resistance Collector Buried Layer eXtrinsic                                     | _     | 0       |
| RCC       | Constant part of the collector resistance                                       | _     | 12      |
| RCV       | Resistance of the un-modulated epilayer   | _     | 150     |
| RE        | Emitter resistance  | _     | 5       |
| SCRCV     | Space charge resistance of the epilayer   | _     | 1250    |
| SFH       | Current spreading factor of avalanche model when EXAVL=1                        | _     | 0.3     |
| TAUB      | Transit time of stored base charge  | _     | 4.2e-12 |
| TAUE      | Minimum transit time of stored emitter charge                                   | _     | 2e-12   |
| TAUR      | Transit time of reverse extrinsic stored base charge                            | _     | 5.2e-10 |
| IEPI      | Transit time of stored epilayer charge  | _     | 4.1e-11 |
| TREF      | Reference temperature   | _     | 25      |
| IVGEB     | Temperature coefficient band-gap voltage for Zener effect emitter-base junction | _     | 636     |
| IYPE      | Flag for NPN (1) or PNP (-1) transistor type                                    | _     | 1       |
| VAVL      | Voltage determining curvature of avalanche current                              | _     | 3       |
| VDC       | Collector-base diffusion voltage  | _     | 0.68    |
| VDE       | Emitter-base diffusion voltage  | _     | 0.95    |
| VDS       | Collector-substrate diffusion voltage   | _     | 0.62    |
| VEF       | Forward Early voltage   | _     | 44      |
| VER       | Reverse Early voltage   | _     | 2.5     |
| VGB       | Band-gap voltage of the base  | _     | 1.17    |
| VGC       | Band-gap voltage of the collector   | _     | 1.18    |
| VGJ       | Band-gap voltage recombination emitter-base junction                            | _     | 1.15    |

Table 2-79. MEXTRAM 504.12.1 Device Model Parameters

| Parameter | Description  | Units | Default  |
|-----------|--|-------|----------|
| VGS       | Band-gap voltage of the substrate                              | _     | 1.2      |
| VGZEB     | Band-gap voltage at Tref of Zener effect emitter-base junction | _     | 1.15     |
| VLR       | Cross-over voltage of the non-ideal reverse base current       |       | 0.2      |
| WAVL      | Epilayer thickness used in weak-avalanche model                | _     | 1.1e-06  |
| XCJC      | Fraction of CB depletion capacitance under the emitter         | _     | 0.032    |
| XCJE      | Sidewall fraction of the emitter-base depletion capacitance    | _     | 0.4      |
| XEXT      | Part of currents and charges that belong to extrinsic region   | _     | 0.63     |
| XIBI      | Part of ideal base current that belongs to the sidewall        | _     | 0        |
| XP        | Constant part of Cjc   | _     | 0.35     |
| XQB       | Emitter-fraction of base diffusion charge                      | _     | 0.333333 |
| XREC      | Pre-factor of the recombination part of Ib1                    | _     | 0        |

Table 2-80. BJT level 504 Output Variables

| Description  | Units  | Default  |
|--|--|--|
| External DC collector current                            | A  | none   |
| External DC base current                                 | A  | none   |
| External DC current gain Ic/Ib                           |  | none   |
| External DC emitter current                              | A  | none   |
| External base-emitter bias                               | V  | none   |
| External collector-emitter bias                          | V  | none   |
| External base-collector bias                             | V  | none   |
| External DC substrate current                            | A  | none   |
| External substrate-emitter bias                          | V  | none   |
| External base-substrate bias                             | V  | none   |
| External substrate-collector bias                        | V  | none   |
| Internal base-emitter bias                               | V  | none   |
| Internal base-collector bias                             | V  | none   |
| Internal base-collector bias including epilayer          | V  | none   |
| External base-collector bias without contact resistances | V  | none   |
| Bias over intrinsic buried layer                         | V  | none   |
| Bias over extrinsic buried layer                         | V  | none   |
|  | External DC base current  External DC current gain Ic/Ib  External DC emitter current  External base-emitter bias  External collector-emitter bias  External base-collector bias  External DC substrate current  External substrate-emitter bias  External substrate bias  External base-substrate bias  Internal base-emitter bias  Internal base-collector bias  Internal base-collector bias  Internal base-collector bias  Internal base-collector bias including epilayer  External base-collector bias without contact resistances  Bias over intrinsic buried layer | External DC collector current  External DC base current  A  External DC current gain Ic/Ib  External DC emitter current  A  External base-emitter bias  V  External collector-emitter bias  V  External base-collector bias  V  External DC substrate current  A  External substrate-emitter bias  V  External substrate-emitter bias  V  External base-substrate bias  V  External base-collector bias  V  Internal base-emitter bias  V  Internal base-collector bias including epilayer  V  External base-collector bias without contact resistances  Bias over intrinsic buried layer  V |

Table 2-80. BJT level 504 Output Variables

| Parameter | Description  | Units         | Default |
|-----------|--|---------------|---------|
| OP_ve1e   | Bias over emitter resistance                         | V             | none    |
| OP_in     | Main current   | A             | none    |
| OP_ic1c2  | Epilayer current                                     | A             | none    |
| OP_ib1b2  | Pinched-base current                                 | A             | none    |
| OP_ib1    | Ideal forward base current                           | A             | none    |
| OP_sib1   | Ideal side-wall base current                         | A             | none    |
| DP_izteb  | Zener tunneling current in the emitter base junction | A             | none    |
| OP_ib2    | Non-ideal forward base current                       | A             | none    |
| OP_ib3    | Non-ideal reverse base current                       | A             | none    |
| DP_iavl   | Avalanche current                                    | A             | none    |
| OP_iex    | Extrinsic reverse base current                       | A             | none    |
| OP_xiex   | Extrinsic reverse base current                       | A             | none    |
| OP_isub   | Substrate current                                    | A             | none    |
| OP_xisub  | Substrate current                                    | A             | none    |
| OP_isf    | Substrate failure current                            | A             | none    |
| OP_ire    | Current through emitter resistance                   | A             | none    |
| OP_irbc   | Current through constant base resistance             | A             | none    |
| OP_ircblx | Current through extrinsic buried layer resistance    | A             | none    |
| OP_ircbli | Current through intrinsic buried layer resistance    | A             | none    |
| OP_ircc   | Current through collector contact resistance         | A             | none    |
| DP_qe     | Emitter charge or emitter neutral charge             | С             | none    |
| DP_qte    | Base-emitter depletion charge                        | C             | none    |
| DP_sqte   | Sidewall base-emitter depletion charge               | С             | none    |
| DP_qbe    | Base-emitter diffusion charge                        | С             | none    |
| OP_qbc    | Base-collector diffusion charge                      | С             | none    |
| OP_qtc    | Base-collector depletion charge                      | С             | none    |
| DP_qepi   | Epilayer diffusion charge                            | С             | none    |
| DP_qb1b2  | AC current crowding charge                           | С             | none    |
| OP_qtex   | Extrinsic base-collector depletion charge            | С             | none    |
| DP_xqtex  | Extrinsic base-collector depletion charge            | С             | none    |
| DP_qex    | Extrinsic base-collector diffusion charge            | С             | none    |
| DP_xqex   | Extrinsic base-collector diffusion charge            | С             | none    |
| DP_qts    | Collector-substrate depletion charge                 | С             | none    |
| DP_gx     | Forward transconductance                             | $\Omega^{-1}$ | none    |
| OP_gy     | Reverse transconductance                             | $\Omega^{-1}$ | none    |
| OP_gz     | Reverse transconductance                             | $\Omega^{-1}$ | none    |

Table 2-80. BJT level 504 Output Variables

| Parameter     | Description                                | Units         | Default |
|---------------|--|---------------|---------|
| DP_sgpi       | Conductance sidewall b-e junction          | $\Omega^{-1}$ | none    |
| OP_gpix       | Conductance floor b-e junction             | $\Omega^{-1}$ | none    |
| OP_gpiy       | Early effect on recombination base current | $\Omega^{-1}$ | none    |
| OP_gpiz       | Early effect on recombination base current | $\Omega^{-1}$ | none    |
| OP_gmux       | Early effect on avalanche current limiting | $\Omega^{-1}$ | none    |
| OP_gmuy       | Conductance of avalanche current           | $\Omega^{-1}$ | none    |
| OP_gmuz       | Conductance of avalanche current           | $\Omega^{-1}$ | none    |
| DP_gmuex      | Conductance of extrinsic b-c junction      | $\Omega^{-1}$ | none    |
| OP_xgmuex     | Conductance of extrinsic b-c junction      | $\Omega^{-1}$ | none    |
| OP_grcvy      | Conductance of epilayer current            | $\Omega^{-1}$ | none    |
| OP_grcvz      | Conductance of epilayer current            | $\Omega^{-1}$ | none    |
| OP_rbv        | Base resistance                            | Ohm           | none    |
| OP_grbvx      | Early effect on base resistance            | $\Omega^{-1}$ | none    |
| OP_grbvy      | Early effect on base resistance            | $\Omega^{-1}$ | none    |
| OP_grbvz      | Early effect on base resistance            | $\Omega^{-1}$ | none    |
| DP_re         | Emitter resistance                         | Ohm           | none    |
| OP_rbc        | Constant base resistance                   | Ohm           | none    |
| OP_rcc        | Collector contact resistance               | Ohm           | none    |
| OP_rcblx      | Extrinsic buried layer resistance          | Ohm           | none    |
| OP_rcbli      | Intrinsic buried layer resistance          | Ohm           | none    |
| OP_gs         | Conductance parasitic PNP transistor       | $\Omega^{-1}$ | none    |
| OP_xgs        | Conductance parasitic PNP transistor       | $\Omega^{-1}$ | none    |
| DP_gsf        | Conductance substrate failure current      | $\Omega^{-1}$ | none    |
| OP_scbe       | Capacitance sidewall b-e junction          | F             | none    |
| OP_cbex       | Capacitance floor b-e junction             | F             | none    |
| OP_cbey       | Early effect on b-e diffusion charge       | F             | none    |
| DP_cbez       | Early effect on b-e diffusion charge       | F             | none    |
| P_cbcx        | Early effect on b-c diffusion charge       | F             | none    |
| OP_cbcy       | Capacitance floor b-c junction             | F             | none    |
| OP_cbcz       | Capacitance floor b-c junction             | F             | none    |
| DP_cbcex      | Capacitance extrinsic b-c junction         | F             | none    |
| OP_xcbcex     | Capacitance extrinsic b-c junction         | F             | none    |
| OP_cb1b2      | Capacitance AC current crowding            | F             | none    |
| OP_cb1b2x     | Cross-capacitance AC current crowding      | F             | none    |
| OP_cb1b2y     | Cross-capacitance AC current crowding      | F             | none    |
| <br>DP_cb1b2z | Cross-capacitance AC current crowding      | F             | none    |

Table 2-80. BJT level 504 Output Variables

| Parameter    | Description                                    | Units         | Default |
|--------------|--|---------------|---------|
| OP_cts       | Capacitance s-c junction                       | F             | none    |
| OP_gm        | transconductance                               | $\Omega^{-1}$ | none    |
| OP_beta      | Current amplification                          |               | none    |
| OP_gout      | Output conductance                             | $\Omega^{-1}$ | none    |
| OP_gmu       | Feedback transconductance                      | $\Omega^{-1}$ | none    |
| OP_rb        | Base resistance                                | Ohm           | none    |
| OP_rc        | Collector resistance                           | Ohm           | none    |
| OP_cbe       | Base-emitter capacitance                       | С             | none    |
| OP_cbc       | Base-collector capacitance                     | С             | none    |
| OP_ft        | Good approximation for cut-off frequency       |               | none    |
| OP_iqs       | Current at onset of quasi-saturation           | A             | none    |
| OP_xiwepi    | Thickness of injection layer                   | m             | none    |
| OP_vb2c2star | Physical value of internal base-collector bias | V             | none    |
| OP_tk        | Actual temperature                             | K             | none    |

Table 2-81. MEXTRAM 504.12.1 with self heating Device Instance Parameters

| Parameter | Description           | Units | Default |
|-----------|-----------------------|-------|---------|
| М         | Alias for MULT        | _     | 1       |
| MULT      | Multiplication factor | _     | 1       |

Table 2-82. MEXTRAM 504.12.1 with self heating Device Model Parameters

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| AB        | Temperature coefficient of the resistivity of the base                          | _     | 1        |
| AC        | Temperature coefficient of the resistivity of the collector contact             | _     | 2        |
| ACBL      | Temperature coefficient of the resistivity of the collector buried layer        | _     | 2        |
| AE        | Temperature coefficient of the resistivity of the emitter                       | _     | 0        |
| AEPI      | Temperature coefficient of the resistivity of the epilayer                      | _     | 2.5      |
| AEX       | Temperature coefficient of the resistivity of the extrinsic base                | _     | 0.62     |
| AF        | Exponent of the Flicker-noise   | _     | 2        |
| AQBO      | Temperature coefficient of the zero-bias base charge                            | _     | 0.3      |
| AS        | Substrate temperature coefficient   | _     | 1.58     |
| ASUB      | Temperature coefficient for mobility of minorities in the substrate             | _     | 2        |
| ATH       | Temperature coefficient of the thermal resistance                               | _     | 0        |
| AVGEB     | Temperature coefficient band-gap voltage for Zener effect emitter-base junction | _     | 0.000473 |
| AXI       | Smoothness parameter for the onset of quasi-saturation                          | _     | 0.3      |
| BF        | Ideal forward current gain  | _     | 215      |
| BRI       | Ideal reverse current gain  | _     | 7        |
| CBCO      | Collector-base overlap capacitance  | _     | 0        |
| CBEO      | Emitter-base overlap capacitance  | _     | 0        |
| CJC       | Zero-bias collector-base depletion capacitance                                  | _     | 7.8e-14  |
| CJE       | Zero-bias emitter-base depletion capacitance                                    | _     | 7.3e-14  |
| CJS       | Zero-bias collector-substrate depletion capacitance                             | _     | 3.15e-13 |
| CTH       | Thermal capacitance   | _     | 3e-09    |
| DAIS      | Fine tuning of temperature dependence of C-E saturation current                 | _     | 0        |
| DEG       | Bandgap difference over the base  | _     | 0        |
|           | <u> </u>  |       |          |

Table 2-82. MEXTRAM 504.12.1 with self heating Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DTA       | Difference between the local and global ambient temperatures   | _     | 0       |
| DVGBF     | Band-gap voltage difference of the forward current gain        | _     | 0.05    |
| DVGBR     | Band-gap voltage difference of the reverse current gain        | _     | 0.045   |
| DVGTE     | Band-gap voltage difference of emitter stored charge           | _     | 0.05    |
| EXAVL     | Flag for extended modeling of avalanche currents               | _     | 0       |
| EXMOD     | Flag for extended modeling of the reverse current gain         | _     | 1       |
| EXPHI     | Flag for the distributed high-frequency effects in transient   | _     | 1       |
| EXSUB     | Flag for extended modelling of substrate currents              | _     | 0       |
| FTAUN     | Fraction of noise transit time to total transit time           |       | 0       |
| GMIN      | Minimum conductance  |       | 1e-13   |
| IBF       | Saturation current of the non-ideal forward base current       | _     | 2.7e-15 |
| IBR       | Saturation current of the non-ideal reverse base current       | _     | 1e-15   |
| ICSS      | Collector-substrate ideal saturation current                   |       | -1      |
| IHC       | Critical current for velocity saturation in the epilayer       | _     | 0.004   |
| IK        | Collector-emitter high injection knee current                  | _     | 0.1     |
| IKS       | Base-substrate high injection knee current                     | _     | 0.00025 |
| IS        | Collector-emitter saturation current                           | _     | 2.2e-17 |
| ISS       | Base-substrate saturation current                              | _     | 4.8e-17 |
| IZEB      | Pre-factor of emitter-base Zener tunneling current             | _     | 0       |
| KAVL      | Switch for white noise contribution due to avalanche           | _     | 0       |
| KC        | Switch for RF correlation noise model selection                | _     | 0       |
| KE        | Fraction of QE in excess phase shift                           | _     | 0       |
| KF        | Flicker-noise coefficient of the ideal base current            | _     | 2e-11   |
| KFN       | Flicker-noise coefficient of the non-ideal base current        |       | 2e-11   |
| LEVEL     | Model level  |       | 504     |
| М         | Alias for MULT   |       | 1       |
| MC        | Coefficient for current modulation of CB depletion capacitance |       | 0.5     |
| MLF       | Non-ideality factor of the non-ideal forward base current      | _     | 2       |
| MTAU      | Non-ideality factor of the emitter stored charge               | _     | 1       |
| MULT      | Multiplication factor  | _     | 1       |

Table 2-82. MEXTRAM 504.12.1 with self heating Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| NZEB      | Coefficient of emitter-base Zener tunneling current                             | _     | 22      |
| PC        | Collector-base grading coefficient  | _     | 0.5     |
| PE        | Emitter-base grading coefficient  | _     | 0.4     |
| PS        | Collector-substrate grading coefficient   | _     | 0.34    |
| RBC       | Constant part of the base resistance  | _     | 23      |
| RBV       | Zero-bias value of the variable part of the base resistance                     | _     | 18      |
| RCBLI     | Resistance Collector Buried Layer Intrinsic                                     | _     | 0       |
| RCBLX     | Resistance Collector Buried Layer eXtrinsic                                     | _     | 0       |
| RCC       | Constant part of the collector resistance                                       | _     | 12      |
| RCV       | Resistance of the un-modulated epilayer   | _     | 150     |
| RE        | Emitter resistance  | _     | 5       |
| RTH       | Thermal resistance  | _     | 300     |
| SCRCV     | Space charge resistance of the epilayer   | _     | 1250    |
| SFH       | Current spreading factor of avalanche model when EXAVL=1                        | _     | 0.3     |
| TAUB      | Transit time of stored base charge  | _     | 4.2e-12 |
| TAUE      | Minimum transit time of stored emitter charge                                   | _     | 2e-12   |
| TAUR      | Transit time of reverse extrinsic stored base charge                            | _     | 5.2e-10 |
| TEPI      | Transit time of stored epilayer charge  | _     | 4.1e-11 |
| TREF      | Reference temperature   | _     | 25      |
| TVGEB     | Temperature coefficient band-gap voltage for Zener effect emitter-base junction | _     | 636     |
| TYPE      | Flag for NPN (1) or PNP (-1) transistor type                                    | _     | 1       |
| VAVL      | Voltage determining curvature of avalanche current                              | _     | 3       |
| VDC       | Collector-base diffusion voltage  | _     | 0.68    |
| VDE       | Emitter-base diffusion voltage  | _     | 0.95    |
| VDS       | Collector-substrate diffusion voltage   | _     | 0.62    |
| VEF       | Forward Early voltage   | _     | 44      |
| VER       | Reverse Early voltage   | _     | 2.5     |
| VGB       | Band-gap voltage of the base  | _     | 1.17    |
| VGC       | Band-gap voltage of the collector   | _     | 1.18    |
| VGJ       | Band-gap voltage recombination emitter-base junction                            | _     | 1.15    |
| VGS       | Band-gap voltage of the substrate   | _     | 1.2     |
| VGZEB     | Band-gap voltage at Tref of Zener effect emitter-base junction                  | _     | 1.15    |

Table 2-82. MEXTRAM 504.12.1 with self heating Device Model Parameters

| Parameter | Description  | Units | Default  |
|-----------|--|-------|----------|
| VLR       | Cross-over voltage of the non-ideal reverse base current     | _     | 0.2      |
| WAVL      | Epilayer thickness used in weak-avalanche model              | _     | 1.1e-06  |
| XCJC      | Fraction of CB depletion capacitance under the emitter       | _     | 0.032    |
| XCJE      | Sidewall fraction of the emitter-base depletion capacitance  | _     | 0.4      |
| XEXT      | Part of currents and charges that belong to extrinsic region | _     | 0.63     |
| XIBI      | Part of ideal base current that belongs to the sidewall      | _     | 0        |
| XP        | Constant part of Cjc   | _     | 0.35     |
| XQB       | Emitter-fraction of base diffusion charge                    | _     | 0.333333 |
| XREC      | Pre-factor of the recombination part of Ib1                  | _     | 0        |

Table 2-83. BJT level 505 Output Variables

| OD :-     |  |   |      |
|-----------|--|---|------|
| OP_ic     | External DC collector current                            | A | none |
| OP_ib     | External DC base current                                 | A | none |
| OP_betadc | External DC current gain Ic/Ib                           |   | none |
| OP_ie     | External DC emitter current                              | A | none |
| OP_vbe    | External base-emitter bias                               | V | none |
| OP_vce    | External collector-emitter bias                          | V | none |
| OP_vbc    | External base-collector bias                             | V | none |
| OP_is     | External DC substrate current                            | A | none |
| OP_vse    | External substrate-emitter bias                          | V | none |
| OP_vbs    | External base-substrate bias                             | V | none |
| OP_vsc    | External substrate-collector bias                        | V | none |
| OP_vb2e1  | Internal base-emitter bias                               | V | none |
| OP_vb2c2  | Internal base-collector bias                             | V | none |
| OP_vb2c1  | Internal base-collector bias including epilayer          | V | none |
| OP_vb1c1  | External base-collector bias without contact resistances | V | none |
| OP_vc4c1  | Bias over intrinsic buried layer                         | V | none |
| OP_vc3c4  | Bias over extrinsic buried layer                         | V | none |
| OP_vele   | Bias over emitter resistance                             | V | none |
| OP_in     | Main current   | A | none |
| OP_ic1c2  | Epilayer current   | A | none |

Table 2-83. BJT level 505 Output Variables

| Parameter | Description  | Units         | Default |
|-----------|--|---------------|---------|
| OP_ib1b2  | Pinched-base current                                 | A             | none    |
| OP_ib1    | Ideal forward base current                           | A             | none    |
| OP_sib1   | Ideal side-wall base current                         | A             | none    |
| OP_izteb  | Zener tunneling current in the emitter base junction | A             | none    |
| OP_ib2    | Non-ideal forward base current                       | A             | none    |
| OP_ib3    | Non-ideal reverse base current                       | A             | none    |
| OP_iavl   | Avalanche current                                    | A             | none    |
| OP_iex    | Extrinsic reverse base current                       | A             | none    |
| OP_xiex   | Extrinsic reverse base current                       | A             | none    |
| OP_isub   | Substrate current                                    | A             | none    |
| OP_xisub  | Substrate current                                    | A             | none    |
| OP_isf    | Substrate failure current                            | A             | none    |
| OP_ire    | Current through emitter resistance                   | A             | none    |
| OP_irbc   | Current through constant base resistance             | A             | none    |
| OP_ircblx | Current through extrinsic buried layer resistance    | A             | none    |
| OP_ircbli | Current through intrinsic buried layer resistance    | A             | none    |
| DP_ircc   | Current through collector contact resistance         | A             | none    |
| OP_qe     | Emitter charge or emitter neutral charge             | С             | none    |
| OP_qte    | Base-emitter depletion charge                        | С             | none    |
| OP_sqte   | Sidewall base-emitter depletion charge               | C             | none    |
| DP_qbe    | Base-emitter diffusion charge                        | С             | none    |
| OP_qbc    | Base-collector diffusion charge                      | С             | none    |
| OP_qtc    | Base-collector depletion charge                      | С             | none    |
| OP_qepi   | Epilayer diffusion charge                            | С             | none    |
| OP_qb1b2  | AC current crowding charge                           | С             | none    |
| OP_qtex   | Extrinsic base-collector depletion charge            | С             | none    |
| DP_xqtex  | Extrinsic base-collector depletion charge            | С             | none    |
| DP_qex    | Extrinsic base-collector diffusion charge            | С             | none    |
| OP_xqex   | Extrinsic base-collector diffusion charge            | С             | none    |
| OP_qts    | Collector-substrate depletion charge                 | С             | none    |
| DP_gx     | Forward transconductance                             | $\Omega^{-1}$ | none    |
| DP_gy     | Reverse transconductance                             | $\Omega^{-1}$ | none    |
| DP_gz     | Reverse transconductance                             | $\Omega^{-1}$ | none    |
| OP_sgpi   | Conductance sidewall b-e junction                    | $\Omega^{-1}$ | none    |
| OP_gpix   | Conductance floor b-e junction                       | $\Omega^{-1}$ | none    |
| OP_gpiy   | Early effect on recombination base current           | $\Omega^{-1}$ | none    |

Table 2-83. BJT level 505 Output Variables

| $OP_gpiz$ Early effect on recombination base current $\Omega^{-1}$ none $OP_gmux$ Early effect on avalanche current $\Omega^{-1}$ none $OP_gmuy$ Conductance of avalanche current $\Omega^{-1}$ none $OP_gmuy$ Conductance of avalanche current $\Omega^{-1}$ none $OP_gmuy$ Conductance of extrinsic be junction $\Omega^{-1}$ none $OP_gmuy$ Conductance of extrinsic be junction $\Omega^{-1}$ none $OP_grevy$ Conductance of epilayer current $\Omega^{-1}$ none $OP_grevy$ Base resistance $O$ hm         none $OP_grevy$ Early effect on base resistance $\Omega^{-1}$ none $OP_grevy$ Early effect on base resistance $\Omega$ hm none <th>Parameter</th> <th>Description</th> <th>Units</th> <th>Default</th>  | Parameter | Description                                | Units         | Default |
|--|-----------|--|---------------|---------|
| OP_gmmy         Conductance of avalanche current $\Omega^{-1}$ none           OP_gmuex         Conductance of extrinsic be- junction $\Omega^{-1}$ none           OP_gmuex         Conductance of extrinsic be- junction $\Omega^{-1}$ none           OP_grovy         Conductance of epilayer current $\Omega^{-1}$ none           OP_grovy         Conductance of epilayer current $\Omega^{-1}$ none           OP_grovy         Conductance of epilayer current $\Omega^{-1}$ none           OP_grbv         Base resistance         Ohm           OP_grbv         Base resistance $\Omega^{-1}$ none           OP_grbvx         Early effect on base resistance $\Omega^{-1}$ none           OP_grbvz         Early effect on base resistance $\Omega^{-1}$ none           OP_yre         Emilter resistance         Ohm none           OP_yre         Emilter resistance         Ohm none           OP_yre         Collector contact resistance         Ohm none           OP_yre   | OP_gpiz   | Early effect on recombination base current | $\Omega^{-1}$ | none    |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | OP_gmux   | Early effect on avalanche current limiting | $\Omega^{-1}$ | none    |
| $\begin{array}{c} \text{OP\_gmuex} & \text{Conductance of extrinsic b-c junction} & \Omega^{-1} & \text{none} \\ \text{OP\_grcvy} & \text{Conductance of extrinsic b-c junction} & \Omega^{-1} & \text{none} \\ \text{OP\_grcvy} & \text{Conductance of epilayer current} & \Omega^{-1} & \text{none} \\ \text{OP\_grcvz} & \text{Conductance of epilayer current} & \Omega^{-1} & \text{none} \\ \text{OP\_grbvx} & \text{Base resistance} & \text{Ohm} & \text{none} \\ \text{OP\_grbvx} & \text{Early effect on base resistance} & \Omega^{-1} & \text{none} \\ \text{OP\_grbvy} & \text{Early effect on base resistance} & \Omega^{-1} & \text{none} \\ \text{OP\_grbvy} & \text{Early effect on base resistance} & \Omega^{-1} & \text{none} \\ \text{OP\_grbvy} & \text{Early effect on base resistance} & \Omega^{-1} & \text{none} \\ \text{OP\_grbvz} & \text{Early effect on base resistance} & \Omega^{-1} & \text{none} \\ \text{OP\_grbvz} & \text{Early effect on base resistance} & \text{Ohm} & \text{none} \\ \text{OP\_grbc} & \text{Constant base resistance} & \text{Ohm} & \text{none} \\ \text{OP\_grbc} & \text{Constant base resistance} & \text{Ohm} & \text{none} \\ \text{OP\_grbc} & \text{Collector contact resistance} & \text{Ohm} & \text{none} \\ \text{OP\_grbc} & \text{Extrinsic buried layer resistance} & \text{Ohm} & \text{none} \\ \text{OP\_grbc} & \text{Conductance parasitic PNP transistor} & \Omega^{-1} & \text{none} \\ \text{OP\_gsg} & \text{Conductance parasitic PNP transistor} & \Omega^{-1} & \text{none} \\ \text{OP\_gsg} & \text{Conductance parasitic PNP transistor} & \Omega^{-1} & \text{none} \\ \text{OP\_gsf} & \text{Conductance substrate failure current} & \Omega^{-1} & \text{none} \\ \text{OP\_gcbey} & \text{Capacitance floor b-e junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance floor b-e diffusion charge} & \text{F} & \text{none} \\ \text{OP\_cbey} & \text{Early effect on b-e diffusion charge} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance floor b-e junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance floor b-e junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance floor b-e junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance floor b-e junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance extrinsic b-c junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance extrinsic b-c junction} & \text{F} & \text{none} \\ \text{OP\_cbex} & \text{Capacitance extrinsic b-c junction} & \text{F} & \text{none} \\ \text{OP\_cblb2x} & Cross-capacita$ | OP_gmuy   | Conductance of avalanche current           | $\Omega^{-1}$ | none    |
| OP_xgmuex         Conductance of extrinsic be-junction $\Omega^{-1}$ none           OP_grcvy         Conductance of epilayer current $\Omega^{-1}$ none           OP_grcv2         Conductance of epilayer current $\Omega^{-1}$ none           OP_rbv         Base resistance         Ohm none           OP_grbvx         Early effect on base resistance $\Omega^{-1}$ none           OP_grbvy         Early effect on base resistance $\Omega^{-1}$ none           OP_grbvz         Early effect on base resistance $\Omega^{-1}$ none           OP_rec         Emitter resistance         Ohm none           OP_rbc         Constant base resistance         Ohm none           OP_rcc         Collector contact resistance         Ohm none           OP_rcc         Collector contact resistance         Ohm none           OP_rcblx         Extrinsic buried layer resistance         Ohm none           OP_rcblx         Extrinsic buried layer resistance         Ohm none           OP_gg         Conductance parasitic PNP transistor $\Omega^{-1}$ none           OP_gg         Conductance parasitic PNP transistor $\Omega^{-1}$ none           OP_gsf         Conductance substrate failure current $\Omega^{-1}$ none           OP_scbe         Capacitance sidewall be junction         F none  | OP_gmuz   | Conductance of avalanche current           | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_gmuex  | Conductance of extrinsic b-c junction      | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_xgmuex | Conductance of extrinsic b-c junction      | $\Omega^{-1}$ | none    |
| OP_zbv         Base resistance         Ohm         none           OP_grbvx         Early effect on base resistance $\Omega^{-1}$ none         none           OP_grbvy         Early effect on base resistance $\Omega^{-1}$ none           OP_grbvz         Early effect on base resistance $\Omega^{-1}$ none           OP_reb         Emitter resistance         Ohm none           OP_rec         Constant base resistance         Ohm none           OP_rcb1x         Extrinsic buried layer resistance         Ohm none           OP_rcb1i         Intrinsic buried layer resistance         Ohm none           OP_gs         Conductance parasitic PNP transistor $\Omega^{-1}$ none           OP_gs         Conductance parasitic PNP transistor $\Omega^{-1}$ none           OP_gsf         Conductance substrate failure current $\Omega^{-1}$ none           OP_gsf         Conductance substrate failure current $\Omega^{-1}$ none           OP_scbe         Capacitance sidewall be junction         F none           OP_cbex         Capacitance floor be junction         F none           OP_cbex         Capacitance floor be diffusion charge         F none           OP_cbex         Early effect on be diffusion charge         F none           OP_cbcx         Capacitance floor be junction <td>OP_grcvy</td> <td>Conductance of epilayer current</td> <td><math>\Omega^{-1}</math></td> <td>none</td>   | OP_grcvy  | Conductance of epilayer current            | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_grcvz  | Conductance of epilayer current            | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_rbv    | Base resistance                            | Ohm           | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_grbvx  | Early effect on base resistance            | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_grbvy  | Early effect on base resistance            | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_grbvz  | Early effect on base resistance            | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_re     | Emitter resistance                         | Ohm           | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_rbc    | Constant base resistance                   | Ohm           | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_rcc    | Collector contact resistance               | Ohm           | none    |
| OP_gs         Conductance parasitic PNP transistor $\Omega^{-1}$ none           OP_xgs         Conductance parasitic PNP transistor $\Omega^{-1}$ none           OP_gsf         Conductance substrate failure current $\Omega^{-1}$ none           OP_scbe         Capacitance sidewall b-e junction         F none           OP_cbex         Capacitance floor b-e junction         F none           OP_cbey         Early effect on b-e diffusion charge         F none           OP_cbez         Early effect on b-e diffusion charge         F none           OP_cbcx         Early effect on b-c diffusion charge         F none           OP_cbcy         Capacitance floor b-c junction         F none           OP_cbcy         Capacitance floor b-c junction         F none           OP_cbcx         Capacitance floor b-c junction         F none           OP_cbcx         Capacitance extrinsic b-c junction         F none           OP_cbcx         Capacitance extrinsic b-c junction         F none           OP_cblb2         Capacitance extrinsic b-c junction         F none           OP_cblb2         Capacitance AC current crowding         F none           OP_cblb2x         Cross-capacitance AC current crowding         F none           OP_cblb2z         Cross-capacitance AC current crowding         F  | OP_rcblx  | Extrinsic buried layer resistance          | Ohm           | none    |
| OP_xgs Conductance parasitic PNP transistor $\Omega^{-1}$ none OP_gsf Conductance substrate failure current $\Omega^{-1}$ none OP_scbe Capacitance sidewall b-e junction F none OP_cbex Capacitance floor b-e junction F none OP_cbey Early effect on b-e diffusion charge F none OP_cbez Early effect on b-e diffusion charge F none OP_cbex Capacitance floor b-c junction F none OP_cbex Capacitance floor b-c junction F none OP_cbey Capacitance floor b-c junction F none OP_cbex Capacitance floor b-c junction F none OP_cbex Capacitance extrinsic b-c junction F none OP_cbex Capacitance extrinsic b-c junction F none OP_cbex Capacitance extrinsic b-c junction F none OP_cblb2 Capacitance AC current crowding F none OP_cblb2 Capacitance AC current crowding F none OP_cblb2y Cross-capacitance AC current crowding F none OP_cblb2y Cross-capacitance AC current crowding F none OP_cblb2z Cross-capacitance AC current crowding F none  | OP_rcbli  | Intrinsic buried layer resistance          | Ohm           | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_gs     | Conductance parasitic PNP transistor       | $\Omega^{-1}$ | none    |
| OP_scbe       Capacitance sidewall b-e junction       F       none         OP_cbex       Capacitance floor b-e junction       F       none         OP_cbey       Early effect on b-e diffusion charge       F       none         OP_cbez       Early effect on b-e diffusion charge       F       none         OP_cbex       Early effect on b-c diffusion charge       F       none         OP_cbcx       Capacitance floor b-c junction       F       none         OP_cbcy       Capacitance floor b-c junction       F       none         OP_cbcx       Capacitance extrinsic b-c junction       F       none         OP_cbcex       Capacitance extrinsic b-c junction       F       none         OP_xcbcex       Capacitance extrinsic b-c junction       F       none         OP_cb1b2       Capacitance AC current crowding       F       none         OP_cb1b2x       Cross-capacitance AC current crowding       F       none         OP_cb1b2y       Cross-capacitance AC current crowding       F       none         OP_cb1b2z       Cross-capacitance AC current crowding       F       none         OP_cts       Capacitance s-c junction       F       none  | OP_xgs    | Conductance parasitic PNP transistor       | $\Omega^{-1}$ | none    |
| OP_cbex       Capacitance floor b-e junction       F       none         OP_cbey       Early effect on b-e diffusion charge       F       none         OP_cbez       Early effect on b-e diffusion charge       F       none         OP_cbcx       Early effect on b-c diffusion charge       F       none         OP_cbcx       Capacitance floor b-c junction       F       none         OP_cbcz       Capacitance floor b-c junction       F       none         OP_cbcex       Capacitance extrinsic b-c junction       F       none         OP_xcbcex       Capacitance extrinsic b-c junction       F       none         OP_cb1b2       Capacitance AC current crowding       F       none         OP_cb1b2x       Cross-capacitance AC current crowding       F       none         OP_cb1b2z       Cross-capacitance AC current crowding       F       none         OP_cb1b2z       Cross-capacitance AC current crowding       F       none         OP_cts       Capacitance s-c junction       F       none         OP_gm       transconductance       Ω <sup>-1</sup> none   | OP_gsf    | Conductance substrate failure current      | $\Omega^{-1}$ | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_scbe   | Capacitance sidewall b-e junction          | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbex   | Capacitance floor b-e junction             | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbey   | Early effect on b-e diffusion charge       | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbez   | Early effect on b-e diffusion charge       | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbcx   | Early effect on b-c diffusion charge       | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbcy   | Capacitance floor b-c junction             | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbcz   | Capacitance floor b-c junction             | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cbcex  | Capacitance extrinsic b-c junction         | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_xcbcex | Capacitance extrinsic b-c junction         | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cb1b2  | Capacitance AC current crowding            | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cb1b2x | Cross-capacitance AC current crowding      | F             | none    |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | OP_cb1b2y | Cross-capacitance AC current crowding      | F             | none    |
| OP_gm transconductance $\Omega^{-1}$ none  | OP_cb1b2z | Cross-capacitance AC current crowding      | F             | none    |
|  | OP_cts    | Capacitance s-c junction                   | F             | none    |
| OP_beta Current amplification none   | OP_gm     | transconductance                           | $\Omega^{-1}$ | none    |
|  | OP_beta   | Current amplification                      |               | none    |

Table 2-83. BJT level 505 Output Variables

| Parameter    | Description                                    | Units         | Default |
|--------------|--|---------------|---------|
| OP_gout      | Output conductance                             | $\Omega^{-1}$ | none    |
| OP_gmu       | Feedback transconductance                      | $\Omega^{-1}$ | none    |
| OP_rb        | Base resistance                                | Ohm           | none    |
| OP_rc        | Collector resistance                           | Ohm           | none    |
| OP_cbe       | Base-emitter capacitance                       | С             | none    |
| OP_cbc       | Base-collector capacitance                     | С             | none    |
| OP_ft        | Good approximation for cut-off frequency       |               | none    |
| OP_iqs       | Current at onset of quasi-saturation           | A             | none    |
| OP_xiwepi    | Thickness of injection layer                   | m             | none    |
| OP_vb2c2star | Physical value of internal base-collector bias | V             | none    |
| OP_pdiss     | Dissipation                                    | W             | none    |
| OP_tk        | Actual temperature                             | K             | none    |

## 2.3.18. Junction Field-Effect Transistor (JFET)



## **Symbol**

Instance Form J<name> <drain node> <gate node> <source node> <model</pre>

name> + [area value] [device parameters]

Examples JIN 100 1 0 JFAST

J13 22 14 23 JNOM 2.0

J1 1 2 0 2N5114

Model Form .MODEL <model name> NJF [model parameters]

.MODEL <model name> PJF [model parameters]

# Parameters and Options

#### drain node

Node connected to drain.

#### gate node

Node connected to gate.

#### source node

Node connected to source.

## source node

Name of model defined in .MODEL line.

#### area value

The JFET is modeled as an intrinsic FET using an ohmic resistance (RD/area) in series with the drain and another ohmic resistance (RS/area) in series with the source. area is an area factor with a default of 1.

## device parameters

Parameters listed in Table 2-84 may be provided as space separated <parameter>=<value> specifications as needed. Any number of parameters may be specified.

#### **Comments**

The JFET was first proposed and analyzed by Shockley. The SPICE- compatible JFET model is an approximation to the Shockley analysis that employs an adjustable parameter B. Both the Shockley formulation and the SPICE approximation are available in Xyce.

**Table 2-84. JFET Device Instance Parameters** 

| Parameter | Description        | Units | Default                |
|-----------|--------------------|-------|------------------------|
| AREA      | Device area        | $m^2$ | 1                      |
| TEMP      | Device temperature | _     | Ambient<br>Temperature |

## **Device Parameters**

**Table 2-85. JFET Device Model Parameters** 

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
| AF        | Flicker noise exponent   | -                | 1                      |
| В         | Doping tail parameter (level 1)                                | $V^{-1}$         | 1                      |
| BETA      | Transconductance parameter                                     | A/V <sup>2</sup> | 0.0001                 |
| CGD       | Zero-bias gate-drain junction capacitance                      | F                | 0                      |
| CGS       | Zero-bias gate-source junction capacitance                     | F                | 0                      |
| DELTA     | Saturation voltage parrameter (level 2)                        | V                | 0                      |
| FC        | Coefficient for forward-bias depletion capacitance             | F                | 0.5                    |
| IS        | Gate junction saturation current                               | A                | 1e-14                  |
| KF        | Flicker noise coefficient                                      | _                | 0.05                   |
| LAMBDA    | Channel length modulation                                      | $V^{-1}$         | 0                      |
| PB        | Gate junction potential  | V                | 1                      |
| RD        | Drain ohmic resistance   | Ω                | 0                      |
| RS        | Source ohmic resistance  | Ω                | 0                      |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature | _                | 'NONE'                 |
| THETA     | Mobility modulation parameter (level 2)                        | $V^{-1}$         | 0                      |
| TNOM      | Nominal device temperature                                     | °C               | Ambient<br>Temperature |
| VTO       | Threshold voltage  | V                | -2                     |

#### **Model Parameters**

**Table 2-86. JFET Device Instance Parameters** 

| Parameter | Description        | Units | Default                |
|-----------|--------------------|-------|------------------------|
| AREA      | Device area        | $m^2$ | 1                      |
| TEMP      | Device temperature | -     | Ambient<br>Temperature |

## **Device Parameters**

**Table 2-87. JFET Device Model Parameters** 

| Parameter | Description  | Units    | Default                |
|-----------|--|----------|------------------------|
| AF        | Flicker noise exponent   | _        | 1                      |
| В         | Doping tail parameter (level 1)                                | $V^{-1}$ | 1                      |
| BETA      | Transconductance parameter                                     | $A/V^2$  | 0.0001                 |
| CGD       | Zero-bias gate-drain junction capacitance                      | F        | 0                      |
| CGS       | Zero-bias gate-source junction capacitance                     | F        | 0                      |
| DELTA     | Saturation voltage parrameter (level 2)                        | V        | 0                      |
| FC        | Coefficient for forward-bias depletion capacitance             | F        | 0.5                    |
| IS        | Gate junction saturation current                               | A        | 1e-14                  |
| KF        | Flicker noise coefficient                                      | _        | 0.05                   |
| LAMBDA    | Channel length modulation                                      | $V^{-1}$ | 0                      |
| PB        | Gate junction potential  | V        | 1                      |
| RD        | Drain ohmic resistance   | Ω        | 0                      |
| RS        | Source ohmic resistance  | Ω        | 0                      |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature | _        | 'NONE'                 |
| THETA     | Mobility modulation parameter (level 2)                        | $V^{-1}$ | 0                      |
| TNOM      | Nominal device temperature                                     | °C       | Ambient<br>Temperature |
| VTO       | Threshold voltage  | V        | -2                     |

## **Model Parameters**

**JFET Level selection** Xyce supports two JFET models. LEVEL=1, the default, is the SPICE 3f5 treatment. This model employs a doping profile parameter B. When B=1, the original SPICE square law is exactly implemented, and when B=0.6 the model is close to that of Shockley.

When LEVEL=2 is selected, the Shockley model is used with some additional physics effects: channel length modulation and the effect of gate electric field on mobility. An additional parameter, DELTA, is added to the LEVEL 2 model that allows the user to adjust the saturation voltage.

**JFET Power Calculations** Power dissipated in the transistor is calculated with  $I_D * V_{DS} + I_G * V_{GS}$  where  $I_D$  is the drain current,  $I_G$  is the gate current,  $V_{DS}$  is the voltage drop between the drain and the source and  $V_{GS}$  is the voltage drop between the gate and the source. This formula may differ from other simulators, such as HSPICE and PSpice.

# 2.3.19. Metal-Semiconductor FET (MESFET)



## **Symbol**

Instance Form Z<name> < drain node> <gate node> <source node> <model name>

+ [area value] [device parameters]

Model Form .MODEL <model name> NMF [model parameters]

.MODEL <model name> PMF [model parameters]

Examples Z1 2 3 0 MESMOD AREA=1.4

Z1 7 2 3 ZM1

# Parameters and Options

#### drain node

Node connected to drain.

#### gate node

Node connected to gate.

#### source node

Node connected to source.

#### source node

Name of model defined in .MODEL line.

#### area value

The MESFET is modeled as an intrinsic FET using an ohmic resistance (RD/area) in series with the drain and another ohmic resistance (RS/area) in series with the source. area value is a scaling factor with a default of 1.

#### device parameters

Parameters listed in Table 2-88 may be provided as space separated <parameter>=<value> specifications as needed. Any number of parameters may be specified.

#### **Comments**

Although MESFETs can be made of Si, such devices are not as common as GaAs MESFETS. And since the mobility of electrons is much higher than holes in GaAs, nearly all commercial devices are n-type MESFETS.

**Table 2-88. MESFET Device Instance Parameters** 

| Parameter | Description        | Units | Default                |
|-----------|--------------------|-------|------------------------|
| AREA      | device area        | $m^2$ | 1                      |
| TEMP      | Device temperature | _     | Ambient<br>Temperature |

# **Device Parameters**

**Table 2-89. MESFET Device Model Parameters** 

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
| AF        | Flicker noise exponent   | _                | 1                      |
| ALPHA     | Saturation voltage parameter                                   | $V^{-1}$         | 2                      |
| В         | Doping tail parameter  | $V^{-1}$         | 0.3                    |
| BETA      | Transconductance parameter                                     | A/V <sup>2</sup> | 0.0025                 |
| CGD       | Zero-bias gate-drain junction capacitance                      | F                | 0                      |
| CGS       | Zero-bias gate-source junction capacitance                     | F                | 0                      |
| FC        | Coefficient for forward-bias depletion capacitance             | F                | 0.5                    |
| IS        | Gate junction saturation current                               | A                | 1e-14                  |
| KF        | Flicker noise coefficient                                      | _                | 0.05                   |
| LAMBDA    | Channel length modulation                                      | $V^{-1}$         | 0                      |
| PB        | Gate junction potential  | V                | 1                      |
| RD        | Drain ohmic resistance   | Ω                | 0                      |
| RS        | Source ohmic resistance  | Ω                | 0                      |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature | _                | 'NONE'                 |
| TNOM      | Nominal device temperature                                     | °C               | Ambient<br>Temperature |
| VTO       | Threshold voltage  | V                | 0                      |

# **Model Parameters**

**MESFET Power Calculations** Power dissipated in the transistor is calculated with  $I_D * V_{DS} + I_G * V_{GS}$  where  $I_D$  is the drain current,  $I_G$  is the gate current,  $V_{DS}$  is the voltage drop between the drain and the source and  $V_{GS}$  is the voltage drop between the gate and the source. This formula may differ from other simulators, such as HSPICE and PSpice.

# 2.3.20. MOS Field Effect Transistor (MOSFET)

#### **Symbol**

#### 

- + <bulk/substrate node> <model name>
- + [L=<value>] [W=<value>]
- + [AD=<value>] [AS=<value>]
- + [PD=<value>] [PS=<value>]
- + [NRD=<value>] [NRS=<value>]
- + [M=<value] [IC=<value, ...>]

# Special Form (BSIMSOI)

M<name> <drain node> <gate node> <source node>

- + <substrate node (E)>
- + [<External body contact (P)>]
- + [<internal body contact (B)>]
- + [<temperature node (T)>]
- + <model name>
- + [L=<value>] [W=<value>]
- + [AD=<value>] [AS=<value>]
- + [PD=<value>] [PS=<value>]
- + [NRD=<value>] [NRS=<value>] [NRB=<value>]
- + [BJTOFF=<value>]
- + [IC=<val>, <val>, <val>, <val>]
- + [RTH0=<val>] [CTH0=<val>]
- + [NBC=<val>] [NSEG=<val>] [PDBCP=<val>] [PSBCP=<val>]
- + [AGBCP=<val>] [AEBCP=<val>] [VBSUSR=<val>] [TNODEOUT]
- + [FRBODY=<val>] [M=<value>]

# Special Form (MVS) Special Form (PSP103 with colf beeting)

M<name> <drain node> <qate node> <source node> <model name>

M<name> <drain node> <gate node> <source node> <bulk node> <dt node>

# self-heating) Model Form

.MODEL <model name> NMOS [model parameters]

.MODEL <model name> PMOS [model parameters]

#### **Examples**

M5 4 12 3 0 PNOM L=20u W=10u

M3 5 13 10 0 PSTRONG

M6 7 13 10 0 PSTRONG M=2

M8 10 12 100 100 NWEAK L=30u W=20u

+ AD=288p AS=288p PD=60u PS=60u NRD=14 NRS=24

# Parameters and Options

L

M The MOSFET channel length and width that are decreased to get the actual channel length and width. They may be given in the device . MODEL or .OPTIONS statements. The value in the device statement overrides the value in the model statement, which overrides the value in the .OPTIONS statement. If  $\mathbb{L}$  or  $\mathbb{W}$  values are not given, their default value is  $100~\mu m$ .

AD

AS The drain and source diffusion areas. Defaults for AD and AS can be set in the .OPTIONS statement. If AD or AS defaults are not set, their default value is 0.

PD

**PS** The drain and source diffusion perimeters. Their default value is 0.

NRD

NRS

Multipliers (in units of  $\square$ ) that can be multiplied by RSH to yield the parasitic (ohmic) resistances of the drain (RD) and source (RS), respectively. NRD, NRS default to 0.

Consider a square sheet of resistive material. Analysis shows that the resistance between two parallel edges of such a sheet depends upon its composition and thickness, but is independent of its size as long as it is square. In other words, the resistance will be the same whether the square's edge is 2 mm, 2 cm, or 2 m. For this reason, the *sheet resistance* of such a layer, abbreviated RSH, has units of Ohms per square, written  $\Omega/\Box$ .

- M If specified, the value is used as a number of parallel MOSFETs to be simulated. For example, if M=2 is specified, Xyce simulates two identical mosfets connected to the same nodes in parallel.
- The BSIM3 (model level 9), BSIM4 (model level 14 or 54) and BSIMSOI (model level 10) allow one to specify the initial voltage difference across nodes of the device during the DC operating point calculation. For the BSIM3 and BSIM4 the syntax is  $IC=V_{ds}$ ,  $V_{gs}$ ,  $V_{bs}$  where  $V_{ds}$  is the voltage difference between the drain and source,  $V_{gs}$  is the voltage difference between the gate and source and  $V_{bs}$  is the voltage difference between the body and source. The BSIMSOI device's initial condition syntax is  $IC=V_{ds}, V_{gs}, V_{bs}, V_{es}, V_{ps}$  where the two extra terms are the voltage difference between the substrate and source, and the external body and source nodes respectively. Note that for any of these lists of voltage differences, fewer than the full number of options may be specified. For example, IC=5.0 specifies an initial condition on  $V_{ds}$  but does not specify any initial conditions on the other nodes. Therefore, one cannot specify  $V_{gs}$  without specifying  $V_{ds}$ , etc. It is illegal to specify initial conditions on any nodes that are tied together. Xyce attempts to catch such errors, but complex circuits may stymie this error trap.

# BSIM-SOI Options

There are a large number of extra instance parameters and optional nodes available for the BSIM-SOI (level 10 (BSIM-SOI 3.2), level 70 (BSIM-SOI 4.6.1), and level 70450 (BSIM-SOI 4.5.0)) MOSFET. Please consult the BSIM-SOI technical manual, available at http://bsim.berkeley.edu/models/bsimsoi/, for full details.

#### substrate node

The fourth node of the BSIM-SOI device is always the substrate node, which is referred to as the E node.

## external body contact node

If given, the fifth node is the external body contact node, P. It is connected to the internal body node through a body tie resistor. If P is not given, the internal body node is not accessible from the netlist and floats.

For the BSIM-SOI 3.2 (level=10) only): If there are only five nodes specified and TNODEOUT is also specified, the fifth node is the temperature node instead.

## internal body contact node

If given, the sixth node is the internal body contact node,  $\mathbb B$ . It is connected to the external body node through a body tie resistor. If  $\mathbb B$  is not given and  $\mathbb P$  is given, the internal body node is not accessible from the netlist, but is still tied to the external body contact through the tie resistance.

For the BSIM-SOI 3.2 (level=10) only): If there are only six nodes specified and TNODEOUT is also specified, the sixth node is the temperature node instead.

#### temperature node

For the BSIM-SOI 3.2 (level=10) only): If the parameter TNODEOUT is specified, the final node (fifth, sixth, or seventh) is interpreted as a temperature node. The temperature node is intended for thermal coupling simulation.

For the BSIM-SOI 4.x (level=70 or 70450) only): The temperature node is only accessible for thermal coupling if it is the seventh node. It is available for printing as an internal node in all other configurations.

#### **BJTOFF**

Turns off the parasitic BJT currents.

The IC parameter allows specification of the five junction initial conditions,  $V_{ds}$ ,  $V_{gs}$ ,  $V_{bs}$ ,  $V_{es}$  and  $V_{ps}$ .  $V_{ps}$  is ignored in a four-terminal device.

#### RTH0

Thermal resistance per unit width. Taken from model card if not given.

#### CTH0

Thermal capacitance per unit width. Taken from model card if not given.

#### NBC

Number of body contact isolation edges.

#### **NSEG**

Number of segments for channel width partitioning.

#### **PDBCP**

Parasitic perimeter length for body contact at drain side.

#### **PSBCP**

Parasitic perimeter length for body contact at source side.

#### **AGBCP**

Parasitic gate-to-body overlap area for body contact.

#### **AEBCP**

Parasitic body-to-substrate overlap area for body contact.

#### **VBSUSR**

Optional initial value of VBS specified by user for use in transient analysis. (unused in Xyce).

#### **FRBODY**

Layout-dependent body resistance coefficient.

#### **Comments**

The simulator provides three MOSFET device models, which differ in the formulation of the I-V characteristic. The LEVEL parameter selects among different models as shown below.

For HSPICE compatibility, the BSIM4 model can be specified with either level 14 or level 54.

**MOSFET Operating Temperature** Model parameters may be assigned unique measurement temperatures using the **TNOM** model parameter. See the MOSFET model parameters for more information.

**MOSFET Power Calculations** Power dissipated in the transistor is calculated with  $I_D * V_{DS} + I_G * V_{GS}$  where  $I_D$  is the drain current,  $I_G$  is the gate current,  $V_{DS}$  is the voltage drop between the drain and the source and  $V_{GS}$  is the voltage drop between the gate and the source. This formula may differ from other simulators, such as HSPICE and PSpice.

**Internal Device Variables Accessible with** N () **Syntax** For the BSIM3, BSIM4, and BSIM-CMG version 110 models, several internal variables have been made accessible with the N () syntax on a .PRINT line. They are  $g_m$  (tranconductance),  $V_{th}$ ,  $V_{ds}$ ,  $V_{gs}$ ,  $V_{bs}$ , and  $V_{dsat}$ . An example .PRINT line command for a MOSFET device named m1 would be:

```
.print dc N(m1:gm) N(m1:Vth) N(m1:Vdsat) N(m1:Vds) N(m1:Vgs) N(m1:Vbs)
```

The BSIM-CMG also supports output of  $I_{ds}$  (drain-source current) in this manner.

If the user runs Xyce -namesfile <filename> <netlist> then Xyce will output into the first filename a list of all solution variables generated by that netlist. This can be useful for determining the "fully-qualified" device name, needed for the N() syntax, if the device is in a subcircuit.

**Instance Parameters** Tables 2-90, 2-92, 2-94, 2-96, 2-98 and 2-100 give the available instance parameters for the levels 1,2,3,6,9 and 10 MOSFETs, respectively.

In addition to the parameters shown in the tables, where a list of numbered initial condition parameters are shown, the MOSFETs support a vector parameter for the initial conditions. IC1 and IC2 may therefore be specified compactly as IC=<ic1>, <ic2>.

**Model Parameters** Tables 2-91, 2-93, 2-95, 2-97, 2-99, and 2-101 give the available model parameters for the levels 1,2,3,6,9 and 10 MOSFETs, respectively.

For a thorough description of MOSFET models see [18, 19, 20, 21, 22, 23, 24, 25, 26, 27].

**All MOSFET models** The parameters shared by all MOSFET model levels are principally parasitic element values (e.g., series resistance, overlap capacitance, etc.).

**Model levels 1 and 3** The DC behaviors of the level 1 and 3 MOSFET models are defined by the parameters **VTO**, **KP**, **LAMBDA**, **PHI**, and **GAMMA**. The simulator calculates these if the process parameters (e.g., **TOX**, and **NSUB**) are specified, but these are always overridden by any user-defined values. The **VTO** value is positive (negative) for modeling the enhancement mode and negative (positive) for the depletion mode of N-channel (P-channel) devices.

For MOSFETs, the capacitance model enforces charge conservation, influencing just the Level 1 and 3 models.

Effective device parameter lengths and widths are calculated as follows:

$$P_i = P_0 + P_L/L_e + P_W/W_e$$

where

$$L_e = \text{effective length} = \mathbf{L} - (2 \cdot \mathbf{LD})$$
  
 $W_e = \text{effective width} = \mathbf{W} - (2 \cdot \mathbf{WD})$ 

See .MODEL (model definition) for more information.

**Model level 9 (BSIM3 version 3.2.2)** The University of California, Berkeley BSIM3 model is a physical-based model with a large number of dependencies on essential dimensional and processing parameters. It incorporates the key effects that are critical in modeling deep-submicrometer MOSFETs. These include threshold voltage reduction, nonuniform doping, mobility reduction due to the vertical field, bulk charge effect, carrier velocity saturation, drain-induced barrier lowering (DIBL), channel length modulation (CLM), hot-carrier-induced output resistance reduction, subthreshold conduction, source/drain parasitic resistance, substrate current induced body effect (SCBE) and drain voltage reduction in LDD structure.

The BSIM3 Version 3.2.2 model is a deep submicron MOSFET model with several major enhancements over earlier versions. These include a single I-V formula used to define the current and output conductance for operating regions, improved narrow width device modeling, a superior capacitance model with improved short and narrow geometry models, a new relaxation-time model to better transient modeling and enhanced model fitting of assorted W/L ratios using a single parameter set. This version preserves the large

number of integrated dependencies on dimensional and processing parameters of the Version 2 model. For further information, see Reference [19].

#### **Additional notes**

1. If any of the following BSIM3 3.2.2 model parameters are not specified, they are computed via the following:

If **VTHO** is not specified, then:

**VTHO** = **VFB** + 
$$\phi_s$$
**K1** $\sqrt{\phi_s}$ 

where:

$$VFB = -1.0$$

If **VTHO** is given, then:

VFB = VTHO - 
$$\phi_s$$
 + K1 $\sqrt{phi_s}$   
VBX =  $\phi_s$  -  $\frac{q \cdot \text{NCH} \cdot \text{XT}^2}{2\varepsilon_{si}}$   
CF =  $\left(\frac{2\varepsilon_{ox}}{\pi}\right) \ln\left(1 + \frac{1}{4 \times 10^7 \cdot \text{TOX}}\right)$ 

where:

$$E_g(T)$$
 = the energy bandgap at temperature  $T = 1.16 - \frac{T^2}{7.02 \times 10^4 (T + 1108)}$ 

2. If **K1** and **K2** are not given then they are computed via the following:

K1 = GAMMA2 - 2 · K2
$$\sqrt{\phi_s - VBM}$$
  
K2 = 
$$\frac{(GAMMA1 - GAMMA2)(\sqrt{\phi_s - VBX} - \sqrt{\phi_s})}{2\sqrt{\phi_s}(\sqrt{\phi_s - VBM} - \sqrt{\phi_s}) + VBM}$$

where:

$$\phi_s = 2V_t \ln \left( \frac{\text{NCH}}{n_i} \right)$$

$$V_t = kT/q$$

$$n_i = 1.45 \times 10^{10} \left( \frac{T}{300.15} \right)^{1.5} \exp \left( 21.5565981 - \frac{E_g(T)}{2V_t} \right)$$

3. If NCH is not specified and GAMMA1 is, then:

$$\mathbf{NCH} = \frac{\mathbf{GAMMA1^2 \times COX^2}}{2q\varepsilon_{si}}$$

If **GAMMA1** and **NCH** are not specified, then **NCH** defaults to  $1.7 \times 10^{23} \ m^{-3}$  and **GAMMA1** is computed using **NCH**:

$$\mathbf{GAMMA1} = \frac{\sqrt{2q\varepsilon_{si} \cdot \mathbf{NCH}}}{\mathbf{COX}}$$

If GAMMA2 is not specified, then:

$$\mathbf{GAMMA2} = \frac{\sqrt{2q\varepsilon_{si} \cdot \mathbf{NSUB}}}{\mathbf{COX}}$$

4. If **CGSO** is not specified and **DLC** > 0, then:

$$\mathbf{CGSO} = \left\{ \begin{array}{ll} 0, & ((\mathbf{DLC} \cdot \mathbf{COX}) - \mathbf{CGSL}) < 0 \\ 0.6 \cdot \mathbf{XJ} \cdot \mathbf{COX}, & ((\mathbf{DLC} \cdot \mathbf{COX}) - \mathbf{CGSL}) \geq 0 \end{array} \right.$$

5. If **CGDO** is not specified and **DLC** > 0, then:

$$\mathbf{CGDO} = \begin{cases} 0, & ((\mathbf{DLC} \cdot \mathbf{COX}) - \mathbf{CGSL}) < 0 \\ 0.6 \cdot \mathbf{XJ} \cdot \mathbf{COX}, & ((\mathbf{DLC} \cdot \mathbf{COX}) - \mathbf{CGSL}) \ge 0 \end{cases}$$

**Model level 10 (BSIM-SOI version 3.2)** The BSIM-SOI is an international standard model for SOI (silicon on insulator) circuit design and is formulated on top of the BSIM3v3 framework. A detailed description can be found in the BSIM-SOI 3.1 User's Manual [28] and the BSIM-SOI 3.2 release notes [29].

This version (v3.2) of the BSIM-SOI includes three depletion models; the partially depleted BSIM-SOI PD (soiMod=0), the fully depleted BSIM-SOI FD (soiMod=2), and the unified SOI model (soiMod=1).

BSIMPD is the Partial-Depletion (PD) mode of the BSIM-SOI. A typical PD SOI MOSFET is formed on a thin SOI film which is layered on top of a buried oxide. BSIMPD has the following features and enhancements:

- Real floating body simulation of both I-V and C-V. The body potential is determined by the balance of all body current components.
- An improved parasitic bipolar current model. This includes enhancements in the various diode leakage components, second order effects (high-level injection and Early effect), diffusion charge equation, and temperature dependence of the diode junction capacitance.
- An improved impact-ionization current model. The contribution from BJT current is also modeled by the parameter Fbjtii.
- A gate-to-body tunneling current model, which is important to thin-oxide SOI technologies.
- Enhancements in the threshold voltage and bulk charge formulation of the high positive body bias regime.
- Instance parameters (Pdbcp, Psbcp, Agbcp, Aebcp, Nbc) are provided to model the parasitics of devices with various body-contact and isolation structures.
- An external body node (the 6th node) and other improvements are introduced to facilitate the modeling of distributed body resistance.
- Self heating. An external temperature node (the 7th node) is supported to facilitate the simulation of thermal coupling among neighboring devices.
- A unique SOI low frequency noise model, including a new excess noise resulting from the floating body effect.
- Width dependence of the body effect is modeled by parameters (K1,K1w1,K1w2).
- Improved history dependence of the body charges with two new parameters (Fbody, DLCB).
- An instance parameter Vbsusr is provided for users to set the transient initial condition of the body potential.

• The new charge-thickness capacitance model introduced in BSIM3v3.2, capMod=3, is included.

**Quadratic Temperature Compensation** SPICE temperature effects are the default, but MOSFET levels 18, 19 and 20 have a more advanced temperature compensation available. By specifying TEMPMODEL=QUADRATIC in the netlist, parameters can be interpolated quadratically between measured values extracted from data. See Section 2.1.21.3 for more details.

**MOSFET Equations** The following equations define an N-channel MOSFET. The P-channel devices use a reverse the sign for all voltages and currents. The equations use the following variables:

 $V_{bs}$  = intrinsic substrate-intrinsic source voltage  $V_{bd}$  = intrinsic substrate-intrinsic drain voltage

 $V_{ds}$  = intrinsic drain-substrate source voltage

 $V_{dsat}$  = saturation voltage

 $V_{gs}$  = intrinsic gate-intrinsic source voltage  $V_{ed}$  = intrinsic gate-intrinsic drain voltage

 $V_t = kT/q$  (thermal voltage)

 $V_{th}$  = threshold voltage

 $C_{ox}$  = the gate oxide capacitance per unit area

f = noise frequency

k = Boltzmann's constant

q = electron charge

Leff = effective channel length

Weff = effective channel width

T = analysis temperature (K)

 $T_0$  = nominal temperature (set using TNOM option)

Other variables are listed in the BJT Equations section 2.3.17.1.

# **All Levels**

$$I_g = \text{gate current} = 0$$
 $I_b = \text{bulk current} = I_{bs} + I_{bd}$ 

where

 $I_{bs} = \text{bulk-source leakage current} = I_{ss} \left( e^{V_{bs}/(NV_t)} - 1 \right)$ 
 $I_{ds} = \text{bulk-drain leakage current} = I_{ds} \left( e^{V_{bd}/(NV_t)} - 1 \right)$ 

where

if

 $JS = 0$ , or  $AS = 0$  or  $AD = 0$ 

then

 $I_{ss} = IS$ 
 $I_{ds} = IS$ 

else

 $I_{ss} = AS \times JS + PS \times JSSW$ 
 $I_{ds} = AD \times JS + PD \times JSSW$ 
 $I_{d} = \text{drain current} = I_{drain} - I_{bd}$ 
 $I_{s} = \text{source current} = -I_{drain} - I_{bs}$ 

Level 1: Idrain

Normal Mode:  $V_{ds} > 0$ 

Case 1

For cutoff region:  $V_{gs} - V_{to} < 0$ 

 $I_{drain} = 0$ 

Case 2

For linear region:  $V_{ds} < V_{gs} - V_{to}$ 

 $I_{drain} = (W/L)(\mathbf{KN}/2)(1 + \mathbf{LAMBDA} \times V_{ds})V_{ds}(2(V_{gs} - V_{to}) - V_{ds})$ 

Case 3

For saturation region:  $0 \le V_{gs} - V_{to} \le V_{ds}$ 

 $I_{drain} = (W/L)(\mathbf{KN}/2)(1 + \mathbf{LAMBDA} \cdot V_{ds})(V_{gs} - V_{to})^2$ 

where

 $V_{to} = \mathbf{VTO} + \mathbf{GAMMA} \cdot \left( (\mathbf{PHI} - V_{bs})^{1/2} \right)^{1/2}$ 

**Inverted Mode:**  $V_{ds} < 0$ 

Here, simply switch the source and drain in the normal mode equations given above.

#### Level 3: Idrain

See Reference [22] below for detailed information.

# Level 1,2, and 3

 $C_{bs}$  = bulk-source capacitance = area cap. + sidewall cap. + transit time cap.

 $C_{bd}$  = bulk-drain capacitance = area cap. + sidewall cap. + transit time cap.

where

then 
$$C_{bs} = \text{As} \cdot \text{CJ} \cdot C_{bsj} + \text{Ps} \cdot \text{CJSW} \cdot C_{bss} + \text{TT} \cdot G_{bs}$$

$$C_{bd} = \text{AD} \cdot \text{CJ} \cdot C_{bdj} + \text{PD} \cdot \text{CJSW} \cdot C_{bds} + \text{TT} \cdot G_{bs}$$

$$else$$

$$C_{bs} = \text{CBs} \cdot C_{bsj} + \text{PS} \cdot \text{CJSW} \cdot C_{bds} + \text{TT} \cdot G_{ds}$$

$$else$$

$$C_{bs} = \text{CBs} \cdot C_{bsj} + \text{PS} \cdot \text{CJSW} \cdot C_{bds} + \text{TT} \cdot G_{ds}$$

$$where$$

$$G_{bs} = \text{DC} \text{ bulk-source conductance} = dl_{bs}/dV_{bs}$$

$$G_{bd} = \text{DC} \text{ bulk-drain conductance} = dl_{bd}/dV_{bd}$$

if

$$V_{bs} \leq \text{FC} \cdot \text{PB}$$
then
$$C_{bsj} = (1 - V_{bs}/\text{PBSW})^{-\text{MJSW}}$$
if

$$V_{bs} > \text{FC} \cdot \text{PB}$$
then
$$C_{bsj} = (1 - \text{FC})^{-(1+\text{MJ})}(1 - \text{FC}(1 + \text{MJ}) + \text{MJ} \cdot V_{bs}/\text{PB})$$

$$C_{bss} = (1 - \text{FC})^{-(1+\text{MJSW})}(1 - \text{FC}(1 + \text{MJSW}) + \text{MJSW} \cdot V_{bs}/\text{PBSW})$$
if

$$V_{bd} \leq \text{FC} \cdot \text{PB}$$
then
$$C_{bdj} = (1 - V_{bd}/\text{PB})^{-\text{MJ}}$$

$$C_{bds} = (1 - V_{bd}/\text{PB})^{-\text{MJ}}$$

$$C_{bds} = (1 - V_{bd}/\text{PBSW})^{-\text{MJSW}}$$
if

$$V_{bd} > \text{FC} \cdot \text{PB}$$
then
$$C_{bdj} = (1 - \text{FC})^{-(1+\text{MJ})}(1 - \text{FC}(1 + \text{MJ}) + \text{MJ} \cdot V_{bd}/\text{PB})$$

$$C_{bds} = (1 - \text{FC})^{-(1+\text{MJSW})}(1 - \text{FC}(1 + \text{MJ}) + \text{MJ} \cdot V_{bd}/\text{PB})$$

$$C_{bds} = (1 - \text{FC})^{-(1+\text{MJSW})}(1 - \text{FC}(1 + \text{MJ}) + \text{MJ} \cdot V_{bd}/\text{PB})$$

$$C_{bds} = (1 - \text{FC})^{-(1+\text{MJSW})}(1 - \text{FC}(1 + \text{MJ}) + \text{MJ} \cdot V_{bd}/\text{PB})$$

$$C_{gd} = \text{gate-source overlap capacitance} = \text{CGBO} \cdot \text{W}$$

$$C_{gd} = \text{gate-drain overlap capacitance} = \text{CGBO} \cdot \text{L}$$

# Capacitance

#### **All Levels**

$$\begin{split} \mathbf{IS}(T) &= \mathbf{IS} \cdot \exp\left(E_g(T_0) \cdot T/T_0 - E_g(T)\right)/V_t \\ \mathbf{JS}(T) &= \mathbf{JS} \cdot \exp\left(E_g(T_0) \cdot T/T_0 - E_g(T)\right)/V_t \\ \mathbf{JSSW}(T) &= \mathbf{JSSW} \cdot \exp\left(E_g(T_0) \cdot T/T_0 - E_g(T)\right)/V_t \\ \mathbf{PB}(T) &= \mathbf{PB} \cdot T/T_0 - 3V_t \ln(T/T_0) - E_g(T_0) \cdot T/T_0 + E_gT \\ \mathbf{PBSW}(T) &= \mathbf{PBSW} \cdot T/T_0 - 3V_t \ln(T/T_0) - E_g(T_0) \cdot T/T_0 + E_gT \\ \mathbf{PHI}(T) &= \mathbf{PHI} \cdot T/T_0 - 3V_t \ln(T/T_0) - E_g(T_0) \cdot T/T_0 + E_gT \end{split}$$

#### where

$$\begin{split} E_g(T) &= \text{silicon bandgap energy} = 1.16 - 0.000702 T^2 / (T + 1108) \\ \mathbf{CBD}(T) &= \mathbf{CBD} \cdot (1 + \mathbf{MJ} \cdot (0.0004 (T - T_0) + (1 - \mathbf{PB}(T) / \mathbf{PB}))) \\ \mathbf{CBS}(T) &= \mathbf{CBS} \cdot (1 + \mathbf{MJ} \cdot (0.0004 (T - T_0) + (1 - \mathbf{PB}(T) / \mathbf{PB}))) \\ \mathbf{CJ}(T) &= \mathbf{CJ} \cdot (1 + \mathbf{MJ} \cdot (0.0004 (T - T_0) + (1 - \mathbf{PB}(T) / \mathbf{PB}))) \\ \mathbf{CJSW}(T) &= \mathbf{CJSW} \cdot (1 + \mathbf{MJSW} \cdot (0.0004 (T - T_0) + (1 - \mathbf{PB}(T) / \mathbf{PB}))) \\ \mathbf{KP}(T) &= \mathbf{KP} \cdot (T / T_0)^{-3/2} \\ \mathbf{UO}(T) &= \mathbf{UO} \cdot (T / T_0)^{-3/2} \\ \mathbf{MUS}(T) &= \mathbf{MUS} \cdot (T / T_0)^{-3/2} \\ \mathbf{X3MS}(T) &= \mathbf{X3MS} \cdot (T / T_0)^{-3/2} \end{split}$$

# **Temperature Effects**

# 2.3.20.1. Level 1 MOSFET Tables (SPICE Level 1)

Table 2-90. MOSFET level 1 Device Instance Parameters

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
| AD        | Drain diffusion area                                       | $m^2$            | 0                      |
| AS        | Source diffusion area                                      | m <sup>2</sup>   | 0                      |
| IC1       | Initial condition on Drain-Source voltage                  | V                | 0                      |
| IC2       | Initial condition on Gate-Source voltage                   | V                | 0                      |
| IC3       | Initial condition on Bulk-Source voltage                   | V                | 0                      |
| L         | Channel length   | m                | 0                      |
| М         | Multiplier for M devices connected in parallel             | _                | 1                      |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |                  | 1                      |
| NRS       | Multiplier for RSH to yield parasitic resistance of source |                  | 1                      |
| OFF       | Initial condition of no voltage drops across device        | logical<br>(T/F) | false                  |
| PD        | Drain diffusion perimeter                                  | m                | 0                      |
| PS        | Source diffusion perimeter                                 | m                | 0                      |
| TEMP      | Device temperature   | °C               | Ambient<br>Temperature |
| W         | Channel width  | m                | 0                      |

Table 2-91. MOSFET level 1 Device Model Parameters

| Parameter | Description                                   | Units            | Default |
|-----------|---|------------------|---------|
| AF        | Flicker noise exponent                        | -                | 1       |
| CBD       | Zero-bias bulk-drain p-n capacitance          | F                | 0       |
| CBS       | Zero-bias bulk-source p-n capacitance         | F                | 0       |
| CGBO      | Gate-bulk overlap capacitance/channel length  | F/m              | 0       |
| CGDO      | Gate-drain overlap capacitance/channel width  | F/m              | 0       |
| CGSO      | Gate-source overlap capacitance/channel width | F/m              | 0       |
| CJ        | Bulk p-n zero-bias bottom capacitance/area    | F/m <sup>2</sup> | 0       |
| CJSW      | Bulk p-n zero-bias sidewall capacitance/area  | F/m <sup>2</sup> | 0       |
| FC        | Bulk p-n forward-bias capacitance coefficient | -                | 0.5     |
| GAMMA     | Bulk threshold parameter                      | $V^{1/2}$        | 0       |
| IS        | Bulk p-n saturation current                   | A                | 1e-14   |
| JS        | Bulk p-n saturation current density           | A/m <sup>2</sup> | 0       |
| KF        | Flicker noise coefficient                     | _                | 0       |

Table 2-91. MOSFET level 1 Device Model Parameters

| Parameter | Description   | Units                  | Default |
|-----------|---|------------------------|---------|
| KP        | Transconductance coefficient  | $A/V^2$                | 2e-05   |
| L         | Default channel length  | m                      | 0.0001  |
| LAMBDA    | Channel-length modulation   | $V^{-1}$               | 0       |
| LD        | Lateral diffusion length  | m                      | 0       |
| MJ        | Bulk p-n bottom grading coefficient   | -                      | 0.5     |
| MJSW      | Bulk p-n sidewall grading coefficient   | _                      | 0.5     |
| NSS       | Surface state density   | $\mathrm{cm}^{-2}$     | 0       |
| NSUB      | Substrate doping density  | $\mathrm{cm}^{-3}$     | 0       |
| PB        | Bulk p-n bottom potential   | V                      | 0.8     |
| PHI       | Surface potential   | V                      | 0.6     |
| RD        | Drain ohmic resistance  | Ω                      | 0       |
| RS        | Source ohmic resistance   | Ω                      | 0       |
| RSH       | Drain, source diffusion sheet resistance  | Ω                      | 0       |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature                      | -                      | 'NONE'  |
| TNOM      | Nominal device temperature  | °C                     | 27      |
| TOX       | Gate oxide thickness  | m                      | 1e-07   |
| TPG       | Gate material type (-1 = same as substrate) 0 = aluminum,1 = opposite of substrate) | _                      | 0       |
| U0        | Surface mobility  | 1/(Vcm <sup>2</sup> s) | 600     |
| UO        | Surface mobility  | 1/(Vcm <sup>2</sup> s) | 600     |
| VTO       | Zero-bias threshold voltage   | V                      | 0       |
| W         | Default channel width   | m                      | 0.0001  |

# 2.3.20.2. Level 2 MOSFET Tables (SPICE Level 2)

Table 2-92. MOSFET level 2 Device Instance Parameters

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
| AD        | Drain diffusion area                                       | $m^2$            | 0                      |
| AS        | Source diffusion area                                      | m <sup>2</sup>   | 0                      |
| IC1       | Initial condition on Drain-Source voltage                  | V                | 0                      |
| IC2       | Initial condition on Gate-Source voltage                   | V                | 0                      |
| IC3       | Initial condition on Bulk-Source voltage                   | V                | 0                      |
| L         | Channel length   | m                | 0                      |
| М         | Multiplier for M devices connected in parallel             | _                | 1                      |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |                  | 1                      |
| NRS       | Multiplier for RSH to yield parasitic resistance of source |                  | 1                      |
| OFF       | Initial condition of no voltage drops across device        | logical<br>(T/F) | false                  |
| PD        | Drain diffusion perimeter                                  | m                | 0                      |
| PS        | Source diffusion perimeter                                 | m                | 0                      |
| TEMP      | Device temperature   | °C               | Ambient<br>Temperature |
| W         | Channel width  | m                | 0                      |

Table 2-93. MOSFET level 2 Device Model Parameters

| Parameter | Description                                   | Units            | Default |
|-----------|---|------------------|---------|
| AF        | Flicker noise exponent                        | _                | 1       |
| CBD       | Zero-bias bulk-drain p-n capacitance          | F                | 0       |
| CBS       | Zero-bias bulk-source p-n capacitance         | F                | 0       |
| CGBO      | Gate-bulk overlap capacitance/channel length  | F/m              | 0       |
| CGDO      | Gate-drain overlap capacitance/channel width  | F/m              | 0       |
| CGSO      | Gate-source overlap capacitance/channel width | F/m              | 0       |
| CJ        | Bulk p-n zero-bias bottom capacitance/area    | F/m <sup>2</sup> | 0       |
| CJSW      | Bulk p-n zero-bias sidewall capacitance/area  | F/m <sup>2</sup> | 0       |
| DELTA     | Width effect on threshold                     | _                | 0       |
| FC        | Bulk p-n forward-bias capacitance coefficient | _                | 0.5     |
| GAMMA     | Bulk threshold parameter                      | $V^{1/2}$        | 0       |
| IS        | Bulk p-n saturation current                   | A                | 1e-14   |
| JS        | Bulk p-n saturation current density           | A/m <sup>2</sup> | 0       |

Table 2-93. MOSFET level 2 Device Model Parameters

| KP         Transconductance coefficient         A/V²         2e-05           L         Default channel length         m         0.0001           LAMBDA         Channel-length modulation         V-1         0           LD         Lateral diffusion length         m         0           MJSW         Bulk p-n bottom grading coefficient         -         0.5           MJSW         Bulk p-n sidewall grading coefficient         -         0.5           NEFF         Total channel charge coeff.         -         1           NES         Fast surface state density         -         0           NSS         Surface state density         cm <sup>-2</sup> 0           NSUB         Substrate doping density         cm <sup>-3</sup> 0           PB         Bulk p-n bottom potential         V         0.6           RD         Drain ohmic resistance         Ω         0           RB         Drain ohmic resistance         Ω         0           RB         Drain, source diffusion sheet resistance         Ω         0           RB         Drain, source diffusion sheet resistance         Ω         0           RB         Drain, source diffusion sheet resistance         Ω         0           R   | Parameter | Description                              | Units                  | Default |
|--|-----------|--|------------------------|---------|
| L         Default channel length         m         0.0001           LAMBDA         Channel-length modulation         V <sup>-1</sup> 0           LD         Lateral diffusion length         m         0           MJSW         Bulk p-n bottom grading coefficient         -         0.5           MISW         Bulk p-n sidewall grading coefficient         -         0.5           NEFF         Total channel charge coeff.         -         1           NES         Fast surface state density         -         0           NES         Surface state density         cm <sup>-2</sup> 0           NSUB         Substrate doping density         cm <sup>-3</sup> 0           PB         Bulk p-n bottom potential         V         0.6           PB         Bulk p-n bottom potential         V         0.6           RED         Drain ohmic resistance         Ω         0           RED         Drain ohmic resistance         Ω         0           RES         Source ohmic resistance         Ω         0           RES         Drain, source diffusion sheet resistance         Ω         0           RES         Drain, source diffusion sheet resistance         Ω         0           TEMPMODEL   | KF        | Flicker noise coefficient                | _                      | 0       |
| LAMBDA       Channel-length modulation       V <sup>-1</sup> 0         LD       Lateral diffusion length       m       0         MJ       Bulk p-n bottom grading coefficient       -       0.5         MJSW       Bulk p-n sidewall grading coefficient       -       0.5         NEFF       Total channel charge coeff.       -       1         NFS       Fast surface state density       -       0         NSS       Surface state density       cm <sup>-2</sup> 0         NSUB       Substrate doping density       cm <sup>-3</sup> 0         PB       Bulk p-n bottom potential       V       0.6         PB       Bulk p-n bottom potential       V       0.6         RD       Drain ohmic resistance       Ω       0         RS       Source ohmic resistance       Ω       0         RS       Source ohmic resistance       Ω       0         RSH       Drain, source diffusion sheet resistance       Ω       0         TEMPMODEL       Specifies the type of parameter interpolation over temperature       °C       27         TOX       Gate oxide thickness       m       1e-07         TPG       Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)   | KP        | Transconductance coefficient             | A/V <sup>2</sup>       | 2e-05   |
| LD Lateral diffusion length m 0  MJ Bulk p-n bottom grading coefficient - 0.5  MJSW Bulk p-n sidewall grading coefficient - 0.5  NEFF Total channel charge coeff 1  NFS Fast surface state density - 0  NSS Surface state density cm <sup>-2</sup> 0  NSUB Substrate doping density cm <sup>-3</sup> 0  PB Bulk p-n bottom potential V 0.8  PB Bulk p-n bottom potential V 0.6  RD Drain ohmic resistance Ω 0  RSS Source ohmic resistance Ω 0  RSS Source ohmic resistance Ω 0  TEMPMODEL Specifies the type of parameter interpolation over temperature cmperature cmcperature cmperature cmperature cmperature cmcperature cmcperatu | L         | Default channel length                   | m                      | 0.0001  |
| Bulk p-n bottom grading coefficient — 0.5  MJSW Bulk p-n sidewall grading coefficient — 0.5  NEFF Total channel charge coeff. — 1  NES Fast surface state density — 0  NSS Surface state density — 0  NSUB Substrate doping density — 0  PB Bulk p-n bottom potential V 0.8  PB Bulk p-n bottom potential V 0.6  PB Drain ohmic resistance Ω 0  RSB Source ohmic resistance Ω 0  RSB Drain, source diffusion sheet resistance Ω 0  TEMPMODEL Specifies the type of parameter interpolation over temperature PC 27  TOX Gate oxide thickness m 1e-07  TOX Gate oxide thickness m 1e-07  TOX Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  DCRIT Crit. field for mob. degradation — 10000  DCRIT Crit. field exp for mob. deg. — 0  Surface mobility 1/(Vcm²s) 600  VMAX Maximum carrier drift velocity — 0  VTO Zero-bias threshold voltage V 0  Default channel width m 0.0001   | LAMBDA    | Channel-length modulation                | $V^{-1}$               | 0       |
| Bulk p-n sidewall grading coefficient — 0.5  NEFF Total channel charge coeff. — 1  NEFS Fast surface state density — 0  NSS Surface state density — 0  NSUB Substrate doping density — 0  PB Bulk p-n bottom potential V 0.8  PB Bulk p-n bottom potential V 0.6  RD Drain ohmic resistance Ω 0  RSS Source ohmic resistance Ω 0  RSS Source officient interpolation over temperature Emperature — NONE  TOO Gate oxide thickness m 1e-07  TOO Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  DCCRIT Crit. field for mob. degradation — 100000  DCCRIT Crit. field for mob. degradation — 0  DCCRIT Crit. field exp for mob. deg. — 0  DCMAX Maximum carrier drift velocity — 0  DCMAX DCMAX Maximum carrier drift velocity — 0   | LD        | Lateral diffusion length                 | m                      | 0       |
| NEFF       Total channel charge coeff.       -       1         NFS       Fast surface state density       -       0         NSS       Surface state density       cm <sup>-2</sup> 0         NSUB       Substrate doping density       cm <sup>-3</sup> 0         PB       Bulk p-n bottom potential       V       0.8         PHI       Surface potential       V       0.6         RD       Drain ohmic resistance       Ω       0         RS       Source ohmic resistance       Ω       0         TOM       Nomial device temperature       °C       2       7         TOX       Gate oxide thickness       m       1e-07  | MJ        | Bulk p-n bottom grading coefficient      | _                      | 0.5     |
| Fast surface state density cm <sup>-2</sup> 0  NSUB Surface state density cm <sup>-3</sup> 0  PE Bulk p-n bottom potential V 0.8  PEH Surface potential V 0.6  RED Drain ohmic resistance Ω 0  RES Source ohmic resistance Ω 0  RES Source officies the type of parameter interpolation over temperature temperature  TOX Gate oxide thickness m 1e-07  TOX Gate oxide thickness m 1e-07  TOX Gate mobility 1/(Vcm <sup>2</sup> s) 600  JUCRIT Crit. field for mob. degradation - 100000  JUCRIT Crit. field exp for mob. deg 0  JUC Surface mobility 1/(Vcm <sup>2</sup> s) 600  JUCRIT Crit. field exp for mob. deg 0  JUC Surface mobility 1/(Vcm <sup>2</sup> s) 600  JUCRIT Crit. field exp for mob. deg 0  JUC Surface mobility 1/(Vcm <sup>2</sup> s) 600  JUCRIT Crit. field exp for mob. deg 0  JUCRIT. Cri   | MJSW      | Bulk p-n sidewall grading coefficient    | _                      | 0.5     |
| Surface state density cm <sup>-2</sup> 0  NSUB  Substrate doping density cm <sup>-3</sup> 0  PB  Bulk p-n bottom potential V 0.8  PHI Surface potential V 0.6  RD  Drain ohmic resistance Ω 0  RSS  Source ohmic resistance Ω 0  RSS  Source ohmic resistance Ω 0  RSSH  Drain,source diffusion sheet resistance Ω 0  Specifies the type of parameter interpolation over temperature  THOM  Nominal device temperature °C 27  TOX  Gate oxide thickness m 1e-07  TPG  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  UO  Surface mobility  JI/(Vcm <sup>2</sup> s) 600  UCRIT  Crit. field for mob. degradation - 100000  UCRIT  Crit. field exp for mob. deg 0  UCRIT   | NEFF      | Total channel charge coeff.              | _                      | 1       |
| NSUB       Substrate doping density       cm $^{-3}$ 0         PB       Bulk p-n bottom potential       V       0.8         PHI       Surface potential       V       0.6         RED       Drain ohmic resistance $\Omega$ 0         RES       Source ohmic resistance $\Omega$ 0         RESH       Drain, source diffusion sheet resistance $\Omega$ 0         RESH       Drain, source diffusion sheet resistance $\Omega$ 0         TEMPMODEL       Specifies the type of parameter interpolation over temperature       -       'NONE         TOM       Nominal device temperature $^{\circ}$ C       27         TOM       Gate oxide thickness       m       1e-07         TOY       Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)       -       0         UCRIT       Crit. field for mob. degradation       -       10000         UCRIT       Crit. field exp for mob. deg.       -       0         UCRYP       Crit. field exp for mob. deg.       -       0         UO       Surface mobility       1/(Vcm²s) 600         WMAX       Maximum carrier drift velocity       -       0         VO       O       Defa  | NFS       | Fast surface state density               | _                      | 0       |
| Bulk p-n bottom potential  V 0.8  PHI Surface potential  V 0.6  RD  Drain ohmic resistance  Ω 0  RS  Source ohmic resistance  Ω 0  TEMPMODEL  Specifies the type of parameter interpolation over temperature  TNOM  Nominal device temperature  NONE  TOX  Gate oxide thickness  m 1e-07  TPG  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  DO  Surface mobility  UCRIT  Crit. field for mob. degradation  DEXP  Crit. field exp for mob. deg.  Crit. field exp for mob. deg.  DO  Surface mobility  V 0  WMAX  Maximum carrier drift velocity  V 0  Default channel width  m 0.0001  | NSS       | Surface state density                    | $\mathrm{cm}^{-2}$     | 0       |
| Surface potential $V$ 0.6  RD Drain ohmic resistance $\Omega$ 0  RS Source ohmic resistance $\Omega$ 0  RSH Drain, source diffusion sheet resistance $\Omega$ 0  Specifies the type of parameter interpolation over temperature  TOOM Nominal device temperature $\Omega$ C 27  TOOM Gate oxide thickness $\Omega$ $\Omega$ 1e-07  TPG  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  USUAL Surface mobility $\Omega$ 1/(Vcm <sup>2</sup> s) 600  UCRIT Crit. field for mob. degradation $\Omega$ 10000  UCRIT Crit. field exp for mob. deg. $\Omega$ 0  UCRIT Crit. field exp for mob. deg. $\Omega$ 0  UCRIT Crit. field exp for mob. deg. $\Omega$ 0  UMAX Maximum carrier drift velocity $\Omega$ 0  VMAX Maximum carrier drift velocity $\Omega$ 0  UNION Default channel width $\Omega$ 0.0001  | NSUB      | Substrate doping density                 | $\mathrm{cm}^{-3}$     | 0       |
| RD       Drain obmic resistance       Ω       0         RS       Source obmic resistance       Ω       0         RSH       Drain, source diffusion sheet resistance       Ω       0         TEMPMODEL       Specifies the type of parameter interpolation over temperature       -       'NONE         TNOM       Nominal device temperature       °C       27         TOX       Gate oxide thickness       m       1e-07         TPG       Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)       -       0         UCO       Surface mobility       1/(Vcm²s)       600         UCRIT       Crit. field for mob. degradation       -       10000         UCRIT       Crit. field exp for mob. deg.       -       0         UCO       Surface mobility       1/(Vcm²s)       600         VMAX       Maximum carrier drift velocity       -       0         VTO       Zero-bias threshold voltage       V       0         W       Default channel width       m       0.0001   | PB        | Bulk p-n bottom potential                | V                      | 0.8     |
| Source ohmic resistance  RSH  Drain,source diffusion sheet resistance  Ω  0  Specifies the type of parameter interpolation over temperature  FINOM  Nominal device temperature  CC  TOX  Gate oxide thickness  m  1e-07  TPG  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  UO  Surface mobility  UCRIT  Crit. field for mob. degradation  Crit. field exp for mob. deg.  Crit. field exp for mob. deg.  Crit. field exp for mob. deg.  CO  Surface mobility  MAX  Maximum carrier drift velocity  A  Default channel width  m  O0001  | PHI       | Surface potential                        | V                      | 0.6     |
| RSH       Drain, source diffusion sheet resistance       Ω       0         TEMPMODEL       Specifies the type of parameter interpolation over temperature       -       'NONE         TNOM       Nominal device temperature       °C       27         TOX       Gate oxide thickness       m       1e-07         TPG       Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)       -       0         JO       Surface mobility       1/(Vcm²s)       600         JURRIT       Crit. field for mob. degradation       -       10000         JUEXP       Crit. field exp for mob. deg.       -       0         JOO       Surface mobility       1/(Vcm²s)       600         VMAX       Maximum carrier drift velocity       -       0         WAX       Maximum carrier drift velocity       -       0         WTO       Zero-bias threshold voltage       V       0         W       Default channel width       m       0.0001   | RD        | Drain ohmic resistance                   | Ω                      | 0       |
| Specifies the type of parameter interpolation over temperature  Nominal device temperature  C 27  COX  Gate oxide thickness  M 1e-07  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  C 27  COX  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  C 30  C 40  C 50  C 60  C 7  C 7  C 7  C 7  C 7  C 7  C 8  C 8  | RS        | Source ohmic resistance                  | Ω                      | 0       |
| temperature  Nominal device temperature  CA 27  TOX Gate oxide thickness m le-07  Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  CA 27  TOX Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  LO Surface mobility l/(Vcm²s) 600  CA 27  TOX Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  LO Surface mobility l/(Vcm²s) 600  CA 27  TOX Gate oxide thickness  M 1e-07  LO Crit. field for mob. degradation  - 10000  CA 27  CO Crit. field oxide oxide thickness  CO CO Crit. field for mob. degradation  - 10000  CA 27  LO Crit. field oxide                  | RSH       | Drain, source diffusion sheet resistance | Ω                      | 0       |
| Gate oxide thickness m 1e-07  Gate material type (-1 = same as substrate, 0 = aluminum,1 = opposite of substrate)  JO Surface mobility 1/(Vcm²s) 600  JCRIT Crit. field for mob. degradation – 10000  JEXP Crit. field exp for mob. deg. – 0  Surface mobility 1/(Vcm²s) 600  VMAX Maximum carrier drift velocity – 0  VTO Zero-bias threshold voltage V 0  Default channel width m 0.0001   | TEMPMODEL | 7.2 2                                    | -                      | 'NONE   |
| Gate material type (-1 = same as substrate, 0 = aluminum, 1 = opposite of substrate)  JOO Surface mobility 1/(Vcm²s) 600  JURIT Crit. field for mob. degradation - 10000  JUEXP Crit. field exp for mob. deg 0  Surface mobility 1/(Vcm²s) 600  VMAX Maximum carrier drift velocity - 0  VMAX Maximum carrier drift velocity - 0  Zero-bias threshold voltage V 0  Default channel width m 0.0001  | TNOM      | Nominal device temperature               | °C                     | 27      |
| aluminum,1 = opposite of substrate)  U0 Surface mobility 1/(Vcm²s) 600  UCRIT Crit. field for mob. degradation - 10000  UEXP Crit. field exp for mob. deg 0  Surface mobility 1/(Vcm²s) 600  VMAX Maximum carrier drift velocity - 0  VTO Zero-bias threshold voltage V 0  Default channel width m 0.0001  | TOX       | Gate oxide thickness                     | m                      | 1e-07   |
| Crit. field for mob. degradation – 10000  DEXP Crit. field exp for mob. deg. – 0  Surface mobility 1/(Vcm²s) 600  VMAX Maximum carrier drift velocity – 0  VTO Zero-bias threshold voltage V 0  Default channel width m 0.0001   | TPG       |  | -                      | 0       |
| Crit. field exp for mob. deg. – 0  Surface mobility 1/(Vcm²s) 600  WMAX Maximum carrier drift velocity – 0  Zero-bias threshold voltage V 0  Default channel width m 0.0001  | U0        | Surface mobility                         | 1/(Vcm <sup>2</sup> s) | 600     |
| Surface mobility 1/(Vcm²s) 600  WMAX Maximum carrier drift velocity – 0  VTO Zero-bias threshold voltage V 0  Default channel width m 0.0001   | UCRIT     | Crit. field for mob. degradation         | _                      | 10000   |
| Maximum carrier drift velocity – 0  VTO Zero-bias threshold voltage V 0  Default channel width m 0.0001  | UEXP      | Crit. field exp for mob. deg.            | _                      | 0       |
| Zero-bias threshold voltage V 0  Default channel width m 0.0001  | UO        | Surface mobility                         | 1/(Vcm <sup>2</sup> s) | 600     |
| Default channel width m 0.0001   | VMAX      | Maximum carrier drift velocity           | _                      | 0       |
|  | VTO       | Zero-bias threshold voltage              | V                      | 0       |
| XJ Junction depth – 0  | W         | Default channel width                    | m                      | 0.0001  |
|  | XJ        | Junction depth                           | -                      | 0       |

# 2.3.20.3. Level 3 MOSFET Tables (SPICE Level 3)

Table 2-94. MOSFET level 3 Device Instance Parameters

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
| AD        | Drain diffusion area                                       | $m^2$            | 0                      |
| AS        | Source diffusion area                                      | m <sup>2</sup>   | 0                      |
| IC1       | Initial condition on Drain-Source voltage                  | V                | 0                      |
| IC2       | Initial condition on Gate-Source voltage                   | V                | 0                      |
| IC3       | Initial condition on Bulk-Source voltage                   | V                | 0                      |
| L         | Channel length   | m                | 0                      |
| М         | Multiplier for M devices connected in parallel             | _                | 1                      |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |                  | 1                      |
| NRS       | Multiplier for RSH to yield parasitic resistance of source |                  | 1                      |
| OFF       | Initial condition of no voltage drops across device        | logical<br>(T/F) | false                  |
| PD        | Drain diffusion perimeter                                  | m                | 0                      |
| PS        | Source diffusion perimeter                                 | m                | 0                      |
| TEMP      | Device temperature   | °C               | Ambient<br>Temperature |
| W         | Channel width  | m                | 0                      |

Table 2-95. MOSFET level 3 Device Model Parameters

| Parameter | Description                                   | Units            | Default |
|-----------|---|------------------|---------|
| AF        | Flicker noise exponent                        | -                | 1       |
| CBD       | Zero-bias bulk-drain p-n capacitance          | F                | 0       |
| CBS       | Zero-bias bulk-source p-n capacitance         | F                | 0       |
| CGBO      | Gate-bulk overlap capacitance/channel length  | F/m              | 0       |
| CGDO      | Gate-drain overlap capacitance/channel width  | F/m              | 0       |
| CGSO      | Gate-source overlap capacitance/channel width | F/m              | 0       |
| CJ        | Bulk p-n zero-bias bottom capacitance/area    | F/m <sup>2</sup> | 0       |
| CJSW      | Bulk p-n zero-bias sidewall capacitance/area  | F/m <sup>2</sup> | 0       |
| DELTA     | Width effect on threshold                     | -                | 0       |
| ETA       | Static feedback                               | -                | 0       |
| FC        | Bulk p-n forward-bias capacitance coefficient | -                | 0.5     |
| GAMMA     | Bulk threshold parameter                      | $V^{1/2}$        | 0       |
| IS        | Bulk p-n saturation current                   | A                | 1e-14   |

Table 2-95. MOSFET level 3 Device Model Parameters

| Parameter | Description  | Units                  | Default |
|-----------|--|------------------------|---------|
| JS        | Bulk p-n saturation current density  | A/m <sup>2</sup>       | 0       |
| KAPPA     | Saturation field factor  | _                      | 0.2     |
| KF        | Flicker noise coefficient  | _                      | 0       |
| KP        | Transconductance coefficient   | A/V <sup>2</sup>       | 2e-05   |
| L         | Default channel length   | m                      | 0.0001  |
| LD        | Lateral diffusion length   | m                      | 0       |
| MJ        | Bulk p-n bottom grading coefficient  | _                      | 0.5     |
| MJSW      | Bulk p-n sidewall grading coefficient  | _                      | 0.33    |
| NFS       | Fast surface state density   | $\mathrm{cm}^{-2}$     | 0       |
| NSS       | Surface state density  | $\mathrm{cm}^{-2}$     | 0       |
| NSUB      | Substrate doping density   | $\mathrm{cm}^{-3}$     | 0       |
| PB        | Bulk p-n bottom potential  | V                      | 0.8     |
| PHI       | Surface potential  | V                      | 0.6     |
| RD        | Drain ohmic resistance   | Ω                      | 0       |
| RS        | Source ohmic resistance  | Ω                      | 0       |
| RSH       | Drain, source diffusion sheet resistance   | Ω                      | 0       |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature                     | -                      | 'NONE'  |
| THETA     | Mobility modulation  | $V^{-1}$               | 0       |
| TNOM      | Nominal device temperature   | °C                     | 27      |
| TOX       | Gate oxide thickness   | m                      | 1e-07   |
| TPG       | Gate material type (-1 = same as substrate,0 = aluminum,1 = opposite of substrate) |                        | 1       |
| U0        | Surface mobility   | 1/(Vcm <sup>2</sup> s) | 600     |
| UO        | Surface mobility   | 1/(Vcm <sup>2</sup> s) | 600     |
| VMAX      | Maximum drift velocity   | m/s                    | 0       |
| VTO       | Zero-bias threshold voltage  | V                      | 0       |
| W         | Default channel width  | m                      | 0.0001  |
| XJ        | Metallurgical junction depth   | m                      | 0       |

# 2.3.20.4. Level 6 MOSFET Tables (SPICE Level 6)

Table 2-96. MOSFET level 6 Device Instance Parameters

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
| AD        | Drain diffusion area                                       | $m^2$            | 0                      |
| AS        | Source diffusion area                                      | m <sup>2</sup>   | 0                      |
| IC1       | Initial condition on Drain-Source voltage                  | V                | 0                      |
| IC2       | Initial condition on Gate-Source voltage                   | V                | 0                      |
| IC3       | Initial condition on Bulk-Source voltage                   | V                | 0                      |
| L         | Channel length   | m                | 0                      |
| М         | Multiplier for M devices connected in parallel             | _                | 1                      |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |                  | 1                      |
| NRS       | Multiplier for RSH to yield parasitic resistance of source |                  | 1                      |
| OFF       | Initial condition of no voltage drops across device        | logical<br>(T/F) | false                  |
| PD        | Drain diffusion perimeter                                  | m                | 0                      |
| PS        | Source diffusion perimeter                                 | m                | 0                      |
| TEMP      | Device temperature   | °C               | Ambient<br>Temperature |
| W         | Channel width  | m                | 0                      |

Table 2-97. MOSFET level 6 Device Model Parameters

| Parameter | Description                                   | Units            | Default |
|-----------|---|------------------|---------|
| AF        | Flicker noise exponent                        | -                | 1       |
| CBD       | Zero-bias bulk-drain p-n capacitance          | F                | 0       |
| CBS       | Zero-bias bulk-source p-n capacitance         | F                | 0       |
| CGBO      | Gate-bulk overlap capacitance/channel length  | F/m              | 0       |
| CGDO      | Gate-drain overlap capacitance/channel width  | F/m              | 0       |
| CGSO      | Gate-source overlap capacitance/channel width | F/m              | 0       |
| CJ        | Bulk p-n zero-bias bottom capacitance/area    | F/m <sup>2</sup> | 0       |
| CJSW      | Bulk p-n zero-bias sidewall capacitance/area  | F/m <sup>2</sup> | 0       |
| FC        | Bulk p-n forward-bias capacitance coefficient | _                | 0.5     |
| GAMMA     | Bulk threshold parameter                      | _                | 0       |
| GAMMA1    | Bulk threshold parameter 1                    | _                | 0       |
| IS        | Bulk p-n saturation current                   | A                | 1e-14   |
| JS        | Bulk p-n saturation current density           | A/m <sup>2</sup> | 0       |

Table 2-97. MOSFET level 6 Device Model Parameters

| Parameter | Description  | Units                  | Default |
|-----------|--|------------------------|---------|
| KC        | Saturation current factor  | _                      | 5e-05   |
| KF        | Flicker noise coefficient  | _                      | 0       |
| KV        | Saturation voltage factor  | _                      | 2       |
| LAMBDA    | Channel length modulation param.   | _                      | 0       |
| LAMBDA0   | Channel length modulation param. 0   | _                      | 0       |
| LAMBDA1   | Channel length modulation param. 1   | _                      | 0       |
| LD        | Lateral diffusion length   | m                      | 0       |
| MJ        | Bulk p-n bottom grading coefficient  | _                      | 0.5     |
| MJSW      | Bulk p-n sidewall grading coefficient  | _                      | 0.5     |
| NC        | Saturation current coeff.  | _                      | 1       |
| NSS       | Surface state density  | $\mathrm{cm}^{-2}$     | 0       |
| NSUB      | Substrate doping density   | $\mathrm{cm}^{-3}$     | 0       |
| NV        | Saturation voltage coeff.  | _                      | 0.5     |
| NVTH      | Threshold voltage coeff.   | _                      | 0.5     |
| PB        | Bulk p-n bottom potential  | V                      | 0.8     |
| PHI       | Surface potential  | V                      | 0.6     |
| PS        | Sat. current modification par.   | _                      | 0       |
| RD        | Drain ohmic resistance   | Ω                      | 0       |
| RS        | Source ohmic resistance  | Ω                      | 0       |
| RSH       | Drain, source diffusion sheet resistance   | Ω                      | 0       |
| SIGMA     | Static feedback effect par.  | _                      | 0       |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature                     | _                      | 'NONE'  |
| TNOM      | Nominal device temperature   | °C                     | 27      |
| TOX       | Gate oxide thickness   | m                      | 1e-07   |
| TPG       | Gate material type (-1 = same as substrate,0 = aluminum,1 = opposite of substrate) | -                      | 1       |
| U0        | Surface mobility   | 1/(Vcm <sup>2</sup> s) | 600     |
| UO        | Surface mobility   | 1/(Vcm <sup>2</sup> s) | 600     |
| VTO       | Zero-bias threshold voltage  | V                      | 0       |

## 2.3.20.5. Level 9 MOSFET Tables (BSIM3)

For complete documentation of the BSIM3 model, see the users' manual for the BSIM3, available for download at http://bsim.berkeley.edu/models/bsim4/bsim3/. Xyce implements Version 3.2.2 of the BSIM3.

In addition to the parameters shown in table 2-98, the BSIM3 supports a vector parameter for the initial conditions. IC1 through IC3 may therefore be specified compactly as IC=<ic1>, <ic2>, <ic3>.

NOTE: Many BSIM3 parameters listed in tables 2-98 and 2-99 as having default values of zero are actually replaced with internally computed defaults if not given. Specifying zero in your model card will override this internal computation. It is recommended that you only set model parameters that you are actually changing from defaults and that you not generate model cards containing default values from the tables.

Table 2-98. BSIM3 Device Instance Parameters

| Parameter | Description  | Units            | Default                |
|-----------|--|------------------|------------------------|
|           | Control Parameters   |                  |                        |
| M         | Multiplier for M devices connected in parallel             | -                | 1                      |
| NQSMOD    | Flag for NQS model   | _                | 0                      |
|           | Geometry Parameters  |                  |                        |
| AD        | Drain diffusion area                                       | $m^2$            | 0                      |
| AS        | Source diffusion area                                      | $m^2$            | 0                      |
| L         | Channel length   | m                | 0                      |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |                  | 1                      |
| NRS       | Multiplier for RSH to yield parasitic resistance of source |                  | 1                      |
| PD        | Drain diffusion perimeter                                  | m                | 0                      |
| PS        | Source diffusion perimeter                                 | m                | 0                      |
| W         | Channel width  | m                | 0                      |
|           | Temperature Parameters                                     |                  |                        |
| TEMP      | Device temperature   | °C               | Ambient<br>Temperature |
|           | Voltage Parameters   |                  |                        |
| IC1       | Initial condition on Vds                                   | V                | 0                      |
| IC2       | Initial condition on Vgs                                   | V                | 0                      |
| IC3       | Initial condition on Vbs                                   | V                | 0                      |
| OFF       | Initial condition of no voltage drops accross device       | logical<br>(T/F) | false                  |
|           |  |                  |                        |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description  | Units            | Default |
|-----------|--|------------------|---------|
|           | Bin Parameters   |                  |         |
| LMAX      | Maximum channel length   | m                | 1       |
| LMIN      | Minimum channel length   | m                | 0       |
| WMAX      | Maximum channel width  | m                | 1       |
| WMIN      | Minimum channel width  | m                | 0       |
|           | Capacitance Parameters   |                  |         |
| ACDE      | Exponetial coefficient for charge thickness in capmod = 3 for accumulation and depletion regions | m/V              | 1       |
| CF        | Firing field capacitance   | F/m              | 0       |
| CGBO      | Gate-bulk overlap capacitance per unit channel length  | F/m              | 0       |
| CGDL      | Light-doped drain-gate region overlap capacitance  | F/m              | 0       |
| CGDO      | Non-LLD region drain-gate overlap capacitance per unit channel length                            | F/m              | 0       |
| CGSL      | Light-doped source-gate region overlap capacitance   | F/m              | 0       |
| CGSO      | Non-LLD region source-gate overlap capacitance per unit channel length                           | F/m              | 0       |
| CJ        | Bulk p-n zero-bias bottom capacitance/area   | F/m <sup>2</sup> | 0.0005  |
| CJSW      | Bulk p-n zero-bias sidewall capacitance/area F   |                  | 5e-10   |
| CJSWG     | Source/grain gate sidewall junction capacitance per unit width                                   | F/m              | 0       |
| CKAPPA    | Coefficient for lightly doped region overlap capacitance fireing field capacitance               | F/m              | 0.6     |
| CLC       | Constant term for short-channel model  |                  | 1e-07   |
| CLE       | Exponetial term for the short-channel model  | _                | 0.6     |
| DLC       | Length offset fitting parameter from C-V   |                  | 0       |
| DWC       | Width offset fitting parameter from C-V  | m                | 0       |
| MJSWG     | Source/grain gate sidewall junction capacitance grading coeficient                               | _                | 0       |
| MOIN      | Coefficient for the gate-bias dependent surface potential  | _                | 15      |
| NOFF      | CV parameter in Vgsteff,CV for weak to strong inversion  | _                | 1       |
| PBSW      | Source/drain side junction built-in potential  | V                | 1       |
| PBSWG     | Source/drain gate sidewall junction built-in potential   | V                | 0       |
| VFBCV     | Flat-band voltage parameter (for CAPMOD = 0 only)  | V                | -1      |
| VOFFCV    | CV parameter in Vgsteff,CV for weak to strong inversion  | V                | 0       |
| XPART     | Charge partitioning rate flag  | _                | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description   | Units                | Default |
|-----------|---|----------------------|---------|
|           | Control Parameters  |                      |         |
| BINUNIT   | Binning unit selector   | _                    | 1       |
| CAPMOD    | Flag for capacitance models   | _                    | 3       |
| MOBMOD    | Mobility model selector   | _                    | 1       |
| NOIMOD    | Flag for noise models   | _                    | 1       |
| PARAMCHK  | Parameter value check   | _                    | 0       |
| VERSION   | Version number  | _                    | '3.2.2' |
|           | DC Parameters   |                      |         |
| A0        | Bulk charge effect coefficient for channel length   | _                    | 1       |
| A1        | First non-saturation effect parameter   | $V^{-1}$             | 0       |
| A2        | Second non-saturation factor  | _                    | 1       |
| AGS       | Gate-bias coefficient of abulk  | $V^{-1}$             | 0       |
| ALPHA0    | First parameter of impact-ionization current  | m/V                  | 0       |
| ALPHA1    | Isub parameter for length scaling   | $V^{-1}$             | 0       |
| в0        | Bulk charge effect coefficient for channel width  | m                    | 0       |
| B1        | Bulk charge effect offset   | m                    | 0       |
| BETA0     | Second parameter of impact-ionization current   | V                    | 30      |
| CDSC      | Drain/source to channel coupling capacitance  | F/m <sup>2</sup>     | 0.00024 |
| CDSCB     | Body-bias sensitivity of CDSC   | F/(Vm <sup>2</sup> ) | 0       |
| CDSCD     | Drain-bias sensitivity of CDSC  | F/(Vm <sup>2</sup> ) | 0       |
| CIT       | Interface trap capacitance  | F/m <sup>2</sup>     | 0       |
| DELTA     | Effective Vds parameter   | V                    | 0.01    |
| DROUT     | L-depedance Coefficient of the DIBL correction parameter in Rout                                  | -                    | 0.56    |
| DSUB      | DIBL coefficient exponent in subthreshhold region   | _                    | 0       |
| DVT0      | First coefficient of short-channel effect effect on threshold voltage                             | -                    | 2.2     |
| DVTOW     | First coefficient of narrow-width effect effect on threshold voltage for small channel length     | $\mathrm{m}^{-1}$    | 0       |
| DVT1      | Second coefficient of short-channel effect effect on threshold voltage                            | -                    | 0.53    |
| DVT1W     | Second coefficient of narrow-width effect effect on threshold voltage for small channel length    | $\mathrm{m}^{-1}$    | 5.3e+06 |
| DVT2      | Body-bias coefficient of short-channel effect effect on threshold voltage                         | $V^{-1}$             | -0.032  |
| DVT2W     | Body-bias coefficient of narrow-width effect effect on threshold voltage for small channel length | $V^{-1}$             | -0.032  |
| DWB       | Coefficient of substrate body bias dependence of Weff   | m/V <sup>1/2</sup>   | 0       |
|           |   |                      |         |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description  | Units              | Default  |
|-----------|--|--------------------|----------|
| DWG       | Coefficient of gate depedence of Weff                      | m/V <sup>1/2</sup> | 0        |
| ETA0      | DIBL coefficient in subthreshold region                    | _                  | 0.08     |
| ETAB      | Body-bias coefficient for the subthreshold DIBL effect     | $V^{-1}$           | -0.07    |
| IJTH      | Diode limiting current                                     | A                  | 0.1      |
| JSW       | Sidewall saturation current per unit length                | A/m                | 0        |
| K1        | First-order body effect coefficient                        | $V^{1/2}$          | 0        |
| K2        | second-order body effect coefficient                       | _                  | 0        |
| K3        | Narrow width coefficient                                   | _                  | 80       |
| КЗВ       | Body effect coefficient of K3                              | $V^{-1}$           | 0        |
| KETA      | Body-bias coefficient of bulk charge effect                | $V^{-1}$           | -0.047   |
| LINT      | Length of offset fiting parameter from I-V without bias    | m                  | 0        |
| LINTNOI   | lint offset for noise calculation                          | m                  | 0        |
| NFACTOR   | Subthreshold swing factor                                  | _                  | 1        |
| NGATE     | Poly gate doping concentration                             | $\mathrm{cm}^{-3}$ | 0        |
| NLX       | Lateral non-uniform doping parameter                       | m                  | 1.74e-07 |
| PCLM      | Channel length modulation parameter                        | _                  | 1.3      |
| PDIBLC1   | First output resistance DIBL effect correction parameter   | _                  | 0.39     |
| PDIBLC2   | Second output resistance DIBL effect correction parameter  | _                  | 0.0086   |
| PDIBLCB   | Body effect coefficient of DIBL correction parameter       | $V^{-1}$           | 0        |
| PRWB      | Body effect coefficient of RDSW                            | $V^{-1/2}$         | 0        |
| PRWG      | Gate-bias effect coefficient of RDSW                       | $V^{-1}$           | 0        |
| PSCBE1    | First substrate current body effect parameter              | $\mathrm{Vm}^{-1}$ | 4.24e+08 |
| PSCBE2    | second substrate current body effect parameter             | $\mathrm{Vm^{-1}}$ | 1e-05    |
| PVAG      | Gate dependence of early voltage                           | _                  | 0        |
| RDSW      | Parasitic resistance per unit width                        | Ω μm               | 0        |
| UA        | First-order mobility degradation coefficient               | m/V                | 2.25e-09 |
| UB        | First-order mobility degradation coefficient               | $m^2/V^2$          | 5.87e-19 |
| UC        | Body effect of mobility degridation coefficient            | m/V <sup>2</sup>   | 0        |
| VBM       | Maximum applied body-bias in threshold voltage calculation | V                  | -3       |
| VFB       | Flat-band voltage  | V                  | 0        |
| MORE      | Offset voltage in the subthreshold region at large W       | V                  | -0.08    |
| VOFF      | and L  |                    |          |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description  | Units             | Default |
|-----------|--|-------------------|---------|
| VTH0      | Threshold voltage at $Vbs = 0$ for large $L$         | V                 | 0       |
| WO        | Narrow-width paameter                                | m                 | 2.5e-06 |
| WINT      | Width-offset fitting parameter from I-V without bias | m                 | 0       |
| WR        | Width offset from Weff for Rds Calculation           | _                 | 1       |
|           | Dependency Parameters                                |                   |         |
| LA0       | Length dependence of A0                              | m                 | 0       |
| LA1       | Length dependence of A1                              | m/V               | 0       |
| LA2       | Length dependence of A2                              | m                 | 0       |
| LACDE     | Length dependence of ACDE                            | m <sup>2</sup> /V | 0       |
| LAGS      | Length dependence of AGS                             | m/V               | 0       |
| LALPHA0   | Length dependence of ALPHA0                          | m <sup>2</sup> /V | 0       |
| LALPHA1   | Length dependence of ALPHA1                          | m/V               | 0       |
| LAT       | Length dependence of AT                              | m <sup>2</sup> /s | 0       |
| LB0       | Length dependence of B0                              | m <sup>2</sup>    | 0       |
| LB1       | Length dependence of B1                              | $m^2$             | 0       |
| LBETA0    | Length dependence of BETA0                           | Vm                | 0       |
| LCDSC     | Length dependence of CDSC                            | F/m               | 0       |
| LCDSCB    | Length dependence of CDSCB                           | F/(Vm)            | 0       |
| LCDSCD    | Length dependence of CDSCD                           | F/(Vm)            | 0       |
| LCF       | Length dependence of CF                              | F                 | 0       |
| LCGDL     | Length dependence of CGDL                            | F                 | 0       |
| LCGSL     | Length dependence of CGSL                            | F                 | 0       |
| LCIT      | Length dependence of CIT                             | F/m               | 0       |
| LCKAPPA   | Length dependence of CKAPPA                          | F                 | 0       |
| LCLC      | Length dependence of CLC                             | m <sup>2</sup>    | 0       |
| LCLE      | Length dependence of CLE                             | m                 | 0       |
| LDELTA    | Length dependence of DELTA                           | Vm                | 0       |
| LDROUT    | Length dependence of DROUT                           | m                 | 0       |
| LDSUB     | Length dependence of DSUB                            | m                 | 0       |
| LDVT0     | Length dependence of DVT0                            | m                 | 0       |
| LDVTOW    | Length dependence of DVT0W                           | _                 | 0       |
| LDVT1     | Length dependence of DVT1                            | m                 | 0       |
| LDVT1W    | Length dependence of DVT1W                           | _                 | 0       |
| LDVT2     | Length dependence of DVT2                            | m/V               | 0       |
|           |  |                   |         |
| LDVT2W    | Length dependence of DVT2W                           | m/V               | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description                  | Units                 | Default |
|-----------|------------------------------|-----------------------|---------|
| LDWG      | Length dependence of DWG     | $m^2/V^{1/2}$         | 0       |
| LELM      | Length dependence of ELM     | m                     | 0       |
| LETA0     | Length dependence of ETA0    | m                     | 0       |
| LETAB     | Length dependence of ETAB    | m/V                   | 0       |
| LGAMMA1   | Length dependence of GAMMA1  | $V^{1/2}$ m           | 0       |
| LGAMMA2   | Length dependence of GAMMA2  | $V^{1/2}$ m           | 0       |
| LK1       | Length dependence of K1      | $V^{1/2}$ m           | 0       |
| LK2       | Length dependence of K2      | m                     | 0       |
| LK3       | Length dependence of K3      | m                     | 0       |
| LK3B      | Length dependence of K3B     | m/V                   | 0       |
| LKETA     | Length dependence of KETA    | m/V                   | 0       |
| LKT1      | Length dependence of KT1     | Vm                    | 0       |
| LKT1L     | Length dependence of KT1L    | Vm <sup>2</sup>       | 0       |
| LKT2      | Length dependence of KT2     | m                     | 0       |
| LMOIN     | Length dependence of MOIN    | m                     | 0       |
| LNCH      | Length dependence of NCH     | m/cm <sup>3</sup>     | 0       |
| LNFACTOR  | Length dependence of NFACTOR | m                     | 0       |
| LNGATE    | Length dependence of NGATE   | m/cm <sup>3</sup>     | 0       |
| LNLX      | Length dependence of NLX     | m <sup>2</sup>        | 0       |
| LNOFF     | Length dependence of NOFF    | m                     | 0       |
| LNSUB     | Length dependence of NSUB    | m/cm <sup>3</sup>     | 0       |
| LPCLM     | Length dependence of PCLM    | m                     | 0       |
| LPDIBLC1  | Length dependence of PDIBLC1 | m                     | 0       |
| LPDIBLC2  | Length dependence of PDIBLC2 | m                     | 0       |
| LPDIBLCB  | Length dependence of PDIBLCB | m/V                   | 0       |
| LPRT      | Length dependence of PRT     | $\Omega \mu$ m m      | 0       |
| LPRWB     | Length dependence of PRWB    | m/V <sup>1/2</sup>    | 0       |
| LPRWG     | Length dependence of PRWG    | m/V                   | 0       |
| LPSCBE1   | Length dependence of PSCBE1  | V                     | 0       |
| LPSCBE2   | Length dependence of PSCBE2  | V                     | 0       |
| LPVAG     | Length dependence of PVAG    | m                     | 0       |
| LRDSW     | Length dependence of RDSW    | $\Omega \mu$ m m      | 0       |
| LU0       | Length dependence of U0      | m/(Vcm <sup>2</sup> s | ) 0     |
| LUA       | Length dependence of UA      | m <sup>2</sup> /V     | 0       |
| LUA1      | Length dependence of UA1     | m <sup>2</sup> /V     | 0       |
| LUB       | Length dependence of UB      | $m^3/V^2$             | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description                     | Units                | Default          |
|-----------|---------------------------------|----------------------|------------------|
| LUB1      | Length dependence of UB1        | $m^3/V^2$            | 0                |
| LUC       | Length dependence of UC         | $m^2/V^2$            | 0                |
| LUC1      | Length dependence of UC1        | m <sup>2</sup> /(°CV | <sup>2</sup> ) 0 |
| LUTE      | Length dependence of UTE        | m                    | 0                |
| LVBM      | Length dependence of VBM        | Vm                   | 0                |
| LVBX      | Length dependence of VBX        | Vm                   | 0                |
| LVFB      | Length dependence of VFB        | Vm                   | 0                |
| LVFBCV    | Length dependence of VFBCV      | Vm                   | 0                |
| LVOFF     | Length dependence of VOFF       | Vm                   | 0                |
| LVOFFCV   | Length dependence of VOFFCV     | Vm                   | 0                |
| LVSAT     | Length dependence of VSAT       | m <sup>2</sup> /s    | 0                |
| LVTH0     | Length dependence of VTH0       | Vm                   | 0                |
| LW0       | Length dependence of W0         | $m^2$                | 0                |
| LWR       | Length dependence of WR         | m                    | 0                |
| LXJ       | Length dependence of XJ         | $m^2$                | 0                |
| LXT       | Length dependence of XT         | $m^2$                | 0                |
| PA0       | Cross-term dependence of A0     | $m^2$                | 0                |
| PA1       | Cross-term dependence of A1     | $m^2/V$              | 0                |
| PA2       | Cross-term dependence of A2     | $m^2$                | 0                |
| PACDE     | Cross-term dependence of ACDE   | $m^3/V$              | 0                |
| PAGS      | Cross-term dependence of AGS    | m <sup>2</sup> /V    | 0                |
| PALPHA0   | Cross-term dependence of ALPHA0 | $m^3/V$              | 0                |
| PALPHA1   | Cross-term dependence of ALPHA1 | $m^2/V$              | 0                |
| PAT       | Cross-term dependence of AT     | m <sup>3</sup> /s    | 0                |
| PB0       | Cross-term dependence of B0     | $m^3$                | 0                |
| PB1       | Cross-term dependence of B1     | $m^3$                | 0                |
| PBETA0    | Cross-term dependence of BETA0  | Vm <sup>2</sup>      | 0                |
| PCDSC     | Cross-term dependence of CDSC   | F                    | 0                |
| PCDSCB    | Cross-term dependence of CDSCB  | F/V                  | 0                |
| PCDSCD    | Cross-term dependence of CDSCD  | F/V                  | 0                |
| PCF       | Cross-term dependence of CF     | Fm                   | 0                |
| PCGDL     | Cross-term dependence of CGDL   | Fm                   | 0                |
| PCGSL     | Cross-term dependence of CGSL   | Fm                   | 0                |
| PCIT      | Cross-term dependence of CIT    | F                    | 0                |
| PCKAPPA   | Cross-term dependence of CKAPPA | Fm                   | 0                |
| PCLC      | Cross-term dependence of CLC    | $m^3$                | 0                |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description                      | Units                           | Default |
|-----------|----------------------------------|---------------------------------|---------|
| PCLE      | Cross-term dependence of CLE     | $m^2$                           | 0       |
| PDELTA    | Cross-term dependence of DELTA   | Vm <sup>2</sup>                 | 0       |
| PDROUT    | Cross-term dependence of DROUT   | $m^2$                           | 0       |
| PDSUB     | Cross-term dependence of DSUB    | m <sup>2</sup>                  | 0       |
| PDVT0     | Cross-term dependence of DVT0    | m <sup>2</sup>                  | 0       |
| PDVT0W    | Cross-term dependence of DVT0W   | m                               | 0       |
| PDVT1     | Cross-term dependence of DVT1    | m <sup>2</sup>                  | 0       |
| PDVT1W    | Cross-term dependence of DVT1W   | m                               | 0       |
| PDVT2     | Cross-term dependence of DVT2    | m <sup>2</sup> /V               | 0       |
| PDVT2W    | Cross-term dependence of DVT2W   | $m^2/V$                         | 0       |
| PDWB      | Cross-term dependence of DWB     | $m^3/V^{1/2}$                   | 0       |
| PDWG      | Cross-term dependence of DWG     | $m^3/V^{1/2}$                   | 0       |
| PELM      | Cross-term dependence of ELM     | $m^2$                           | 0       |
| PETA0     | Cross-term dependence of ETA0    | $m^2$                           | 0       |
| PETAB     | Cross-term dependence of ETAB    | $m^2/V$                         | 0       |
| PGAMMA1   | Cross-term dependence of GAMMA1  | $V^{1/2}m^2$                    | 0       |
| PGAMMA2   | Cross-term dependence of GAMMA2  | $V^{1/2}m^2$                    | 0       |
| PK1       | Cross-term dependence of K1      | $V^{1/2}m^2$                    | 0       |
| PK2       | Cross-term dependence of K2      | $m^2$                           | 0       |
| PK3       | Cross-term dependence of K3      | $m^2$                           | 0       |
| PK3B      | Cross-term dependence of K3B     | m <sup>2</sup> /V               | 0       |
| PKETA     | Cross-term dependence of KETA    | $m^2/V$                         | 0       |
| PKT1      | Cross-term dependence of KT1     | Vm <sup>2</sup>                 | 0       |
| PKT1L     | Cross-term dependence of KT1L    | Vm <sup>3</sup>                 | 0       |
| PKT2      | Cross-term dependence of KT2     | $m^2$                           | 0       |
| PMOIN     | Cross-term dependence of MOIN    | m <sup>2</sup>                  | 0       |
| PNCH      | Cross-term dependence of NCH     | m <sup>2</sup> /cm <sup>3</sup> | 0       |
| PNFACTOR  | Cross-term dependence of NFACTOR | $m^2$                           | 0       |
| PNGATE    | Cross-term dependence of NGATE   | m <sup>2</sup> /cm <sup>3</sup> | 0       |
| PNLX      | Cross-term dependence of NLX     | $m^3$                           | 0       |
| PNOFF     | Cross-term dependence of NOFF    | $m^2$                           | 0       |
| PNSUB     | Cross-term dependence of NSUB    | m <sup>2</sup> /cm <sup>3</sup> | 0       |
| PPCLM     | Cross-term dependence of PCLM    | m <sup>2</sup>                  | 0       |
| PPDIBLC1  | Cross-term dependence of PDIBLC1 | $m^2$                           | 0       |
| PPDIBLC2  | Cross-term dependence of PDIBLC2 | $m^2$                           | 0       |
| PPDIBLCB  | Cross-term dependence of PDIBLCB | m <sup>2</sup> /V               | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description                     | Units                               | Default |
|-----------|---------------------------------|-------------------------------------|---------|
| PPRT      | Cross-term dependence of PRT    | $\Omega  \mu$ m $m^2$               | 0       |
| PPRWB     | Cross-term dependence of PRWB   | $m^2/V^{1/2}$                       | 0       |
| PPRWG     | Cross-term dependence of PRWG   | m <sup>2</sup> /V                   | 0       |
| PPSCBE1   | Cross-term dependence of PSCBE1 | Vm                                  | 0       |
| PPSCBE2   | Cross-term dependence of PSCBE2 | Vm                                  | 0       |
| PPVAG     | Cross-term dependence of PVAG   | $m^2$                               | 0       |
| PRDSW     | Cross-term dependence of RDSW   | $\Omega  \mu$ m $m^2$               | 0       |
| PU0       | Cross-term dependence of U0     | m <sup>2</sup> /(Vcm <sup>2</sup>   | s)0     |
| PUA       | Cross-term dependence of UA     | m <sup>3</sup> /V                   | 0       |
| PUA1      | Cross-term dependence of UA1    | m <sup>3</sup> /V                   | 0       |
| PUB       | Cross-term dependence of UB     | $m^4/V^2$                           | 0       |
| PUB1      | Cross-term dependence of UB1    | $m^4/V^2$                           | 0       |
| PUC       | Cross-term dependence of UC     | $m^3/V^2$                           | 0       |
| PUC1      | Cross-term dependence of UC1    | m <sup>3</sup> /(°CV <sup>2</sup> ) | 0       |
| PUTE      | Cross-term dependence of UTE    | $m^2$                               | 0       |
| PVBM      | Cross-term dependence of VBM    | Vm <sup>2</sup>                     | 0       |
| PVBX      | Cross-term dependence of VBX    | Vm <sup>2</sup>                     | 0       |
| PVFB      | Cross-term dependence of VFB    | Vm <sup>2</sup>                     | 0       |
| PVFBCV    | Cross-term dependence of VFBCV  | Vm <sup>2</sup>                     | 0       |
| PVOFF     | Cross-term dependence of VOFF   | Vm <sup>2</sup>                     | 0       |
| PVOFFCV   | Cross-term dependence of VOFFCV | Vm <sup>2</sup>                     | 0       |
| PVSAT     | Cross-term dependence of VSAT   | m <sup>3</sup> /s                   | 0       |
| PVTH0     | Cross-term dependence of VTH0   | Vm <sup>2</sup>                     | 0       |
| PW0       | Cross-term dependence of W0     | $m^3$                               | 0       |
| PWR       | Cross-term dependence of WR     | $m^2$                               | 0       |
| PXJ       | Cross-term dependence of XJ     | $m^3$                               | 0       |
| PXT       | Cross-term dependence of XT     | $m^3$                               | 0       |
| WA0       | Width dependence of A0          | m                                   | 0       |
| WA1       | Width dependence of A1          | m/V                                 | 0       |
| WA2       | Width dependence of A2          | m                                   | 0       |
| WACDE     | Width dependence of ACDE        | m <sup>2</sup> /V                   | 0       |
| WAGS      | Width dependence of AGS         | m/V                                 | 0       |
| WALPHA0   | Width dependence of ALPHA0      | m <sup>2</sup> /V                   | 0       |
| WALPHA1   | Width dependence of ALPHA1      | m/V                                 | 0       |
|           |                                 |                                     |         |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description                | Units             | Default |
|-----------|----------------------------|-------------------|---------|
| WAT       | Width dependence of AT     | m <sup>2</sup> /s | 0       |
| WB0       | Width dependence of B0     | $m^2$             | 0       |
| WB1       | Width dependence of B1     | $m^2$             | 0       |
| WBETA0    | Width dependence of BETA0  | Vm                | 0       |
| WCDSC     | Width dependence of CDSC   | F/m               | 0       |
| WCDSCB    | Width dependence of CDSCB  | F/(Vm)            | 0       |
| WCDSCD    | Width dependence of CDSCD  | F/(Vm)            | 0       |
| WCF       | Width dependence of CF     | F                 | 0       |
| WCGDL     | Width dependence of CGDL   | F                 | 0       |
| WCGSL     | Width dependence of CGSL   | F                 | 0       |
| WCIT      | Width dependence of CIT    | F/m               | 0       |
| WCKAPPA   | Width dependence of CKAPPA | F                 | 0       |
| WCLC      | Width dependence of CLC    | $m^2$             | 0       |
| WCLE      | Width dependence of CLE    | m                 | 0       |
| WDELTA    | Width dependence of DELTA  | Vm                | 0       |
| WDROUT    | Width dependence of DROUT  | m                 | 0       |
| WDSUB     | Width dependence of DSUB   | m                 | 0       |
| WDVT0     | Width dependence of DVT0   | m                 | 0       |
| WDVTOW    | Width dependence of DVT0W  | _                 | 0       |
| WDVT1     | Width dependence of DVT1   | m                 | 0       |
| WDVT1W    | Width dependence of DVT1W  | -                 | 0       |
| WDVT2     | Width dependence of DVT2   | m/V               | 0       |
| WDVT2W    | Width dependence of DVT2W  | m/V               | 0       |
| WDWB      | Width dependence of DWB    | $m^2/V^{1/2}$     | 0       |
| WDWG      | Width dependence of DWG    | $m^2/V^{1/2}$     | 0       |
| WELM      | Width dependence of ELM    | m                 | 0       |
| WETA0     | Width dependence of ETA0   | m                 | 0       |
| WETAB     | Width dependence of ETAB   | m/V               | 0       |
| WGAMMA1   | Width dependence of GAMMA1 | $V^{1/2}$ m       | 0       |
| WGAMMA2   | Width dependence of GAMMA2 | $V^{1/2}$ m       | 0       |
| WK1       | Width dependence of K1     | $V^{1/2}$ m       | 0       |
| WK2       | Width dependence of K2     | m                 | 0       |
| wK3       | Width dependence of K3     | m                 | 0       |
| WK3B      | Width dependence of K3B    | m/V               | 0       |
| WKETA     | Width dependence of KETA   | m/V               | 0       |
| WKT1      | Width dependence of KT1    | Vm                | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description                 | Units                               | Default |
|-----------|-----------------------------|-------------------------------------|---------|
| WKT1L     | Width dependence of KT1L    | Vm <sup>2</sup>                     | 0       |
| WKT2      | Width dependence of KT2     | m                                   | 0       |
| WMOIN     | Width dependence of MOIN    | m                                   | 0       |
| WNCH      | Width dependence of NCH     | m/cm <sup>3</sup>                   | 0       |
| WNFACTOR  | Width dependence of NFACTOR | m                                   | 0       |
| WNGATE    | Width dependence of NGATE   | m/cm <sup>3</sup>                   | 0       |
| WNLX      | Width dependence of NLX     | $m^2$                               | 0       |
| WNOFF     | Width dependence of NOFF    | m                                   | 0       |
| WNSUB     | Width dependence of NSUB    | m/cm <sup>3</sup>                   | 0       |
| WPCLM     | Width dependence of PCLM    | m                                   | 0       |
| WPDIBLC1  | Width dependence of PDIBLC1 | m                                   | 0       |
| WPDIBLC2  | Width dependence of PDIBLC2 | m                                   | 0       |
| WPDIBLCB  | Width dependence of PDIBLCB | m/V                                 | 0       |
| WPRT      | Width dependence of PRT     | $\Omega \mu$ m m                    | 0       |
| WPRWB     | Width dependence of PRWB    | $m/V^{1/2}$                         | 0       |
| WPRWG     | Width dependence of PRWG    | m/V                                 | 0       |
| WPSCBE1   | Width dependence of PSCBE1  | V                                   | 0       |
| WPSCBE2   | Width dependence of PSCBE2  | V                                   | 0       |
| WPVAG     | Width dependence of PVAG    | m                                   | 0       |
| WRDSW     | Width dependence of RDSW    | $\Omega \mu$ m m                    | 0       |
| WU0       | Width dependence of U0      | m/(Vcm <sup>2</sup> s)              | 0       |
| WUA       | Width dependence of UA      | $m^2/V$                             | 0       |
| WUA1      | Width dependence of UA1     | m <sup>2</sup> /V                   | 0       |
| WUB       | Width dependence of UB      | $m^3/V^2$                           | 0       |
| WUB1      | Width dependence of UB1     | $m^3/V^2$                           | 0       |
| WUC       | Width dependence of UC      | $m^2/V^2$                           | 0       |
| WUC1      | Width dependence of UC1     | m <sup>2</sup> /(°CV <sup>2</sup> ) | 0       |
| WUTE      | Width dependence of UTE     | m                                   | 0       |
| WVBM      | Width dependence of VBM     | Vm                                  | 0       |
| WVBX      | Width dependence of VBX     | Vm                                  | 0       |
| NVFB      | Width dependence of VFB     | Vm                                  | 0       |
| WVFBCV    | Width dependence of VFBCV   | Vm                                  | 0       |
| WVOFF     | Width dependence of VOFF    | Vm                                  | 0       |
| WVOFFCV   | Width dependence of VOFFCV  | Vm                                  | 0       |
| WVSAT     | Width dependence of VSAT    | m <sup>2</sup> /s                   | 0       |
| WVTH0     | Width dependence of VTH0    | Vm                                  | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description   | Units                | Default |
|-----------|---|----------------------|---------|
| WWO       | Width dependence of W0  | $m^2$                | 0       |
| WWR       | Width dependence of WR  | m                    | 0       |
| WXJ       | Width dependence of XJ  | $m^2$                | 0       |
| WXT       | Width dependence of XT  | m <sup>2</sup>       | 0       |
|           | Doping Parameters   |                      |         |
| MJ        | Bulk p-n bottom grading coefficient                                     | _                    | 0.5     |
| MJSW      | Bulk p-n sidewall grading coefficient                                   | _                    | 0.33    |
| NSUB      | Substrate doping density  | $cm^{-3}$            | 6e+16   |
|           | Flicker and Thermal Noise Parameters                                    |                      |         |
| AF        | Flicker noise exponent  | _                    | 1       |
| EF        | Flicker exponent  | _                    | 1       |
| EM        | Saturation field  | $Vm^{-1}$            | 4.1e+07 |
| KF        | Flicker noise coefficient   | _                    | 0       |
| NOIA      | Noise parameter a   | _                    | 0       |
| NOIB      | Noise parameter b   | _                    | 0       |
| NOIC      | Noise parameter c   | _                    | 0       |
|           | Geometry Parameters   |                      |         |
| L         | Channel length  | m                    | 5e-06   |
| LL        | Coefficient of length dependence for length offset                      | $m^{LLN}$            | 0       |
| LLC       | Coefficient of length dependence for CV channel length offset           | m <sup>LLN</sup>     | 0       |
| LLN       | Power of length dependence for length offset                            | _                    | 0       |
| LW        | Coefficient of width dependence for length offset                       | $m^{LWN}$            | 0       |
| LWC       | Coefficient of width dependence for channel length offset               | m <sup>LWN</sup>     | 0       |
| LWL       | Coefficient of length and width cross term for length offset            | m <sup>LLN+LWN</sup> | 0       |
| LWLC      | Coefficient of length and width dependence for CV channel length offset | m <sup>LLN+LWN</sup> | 0       |
| LWN       | Power of width dependence for length offset                             | _                    | 0       |
| TOX       | Gate oxide thickness  | m                    | 1.5e-08 |
| W         | Channel width   | m                    | 5e-06   |
| WL        | Coefficient of length dependence for width offset                       | $m^{WLN}$            | 0       |
| WLC       | Coefficient of length dependence for CV channel width offset            |                      | 0       |
| WLN       | Power of length dependece of width offset                               | _                    | 0       |
| WW        | Coefficient of width dependence for width offset                        | m <sup>WWN</sup>     | 0       |

Table 2-99. BSIM3 Device Model Parameters

| Parameter | Description   | Units                  | Default                |
|-----------|---|------------------------|------------------------|
| WWC       | Coefficient of width dependence for CV channel width offset                       | m <sup>WWN</sup>       | 0                      |
| WWL       | Coefficient of length and width cross term for width offset                       | m <sup>WLN+WWN</sup> 0 |                        |
| WWLC      | Coefficient of length and width dependence for CV channel width offset            | m <sup>WLN+WWN</sup> 0 |                        |
| WWN       | Power of width dependence of width offset   | _                      | 0                      |
| XJ        | Junction depth  | m                      | 1.5e-07                |
|           | NQS Parameters  |                        |                        |
| ELM       | Elmore constant of the channel  | _                      | 5                      |
|           | Resistance Parameters   |                        |                        |
| RSH       | Drain, source diffusion sheet resistance  | Ω                      | 0                      |
|           | Process Parameters  |                        |                        |
| GAMMA1    | Body effect coefficient near the surface  | $V^{1/2}$              | 0                      |
| GAMMA2    | Body effect coefficient in the bulk   | $V^{1/2}$              | 0                      |
| JS        | Bulk p-n saturation current density   | A/m <sup>2</sup>       | 0.0001                 |
| NCH       | Channel doping concentration  | $cm^{-3}$              | 1.7e+17                |
| TOXM      | Gate oxide thickness used in extraction   | m                      | 0                      |
| U0        | Surface mobility  | 1/(Vcm <sup>2</sup> s) | 0                      |
| VBX       | Vbs at which the depetion region = XT   | V                      | 0                      |
| XT        | Doping depth  | m                      | 1.55e-07               |
|           | Temperature Parameters  |                        |                        |
| AT        | Temperature coefficient for saturation velocity                                   | m/s                    | 33000                  |
| KT1       | Temperature coefficient for threshold voltage                                     | V                      | -0.11                  |
| KT1L      | Channel length dependence of the temerature coefficient for the threshold voltage | Vm                     | 0                      |
| KT2       | Body-bias coefficient fo the threshold voltage temperature effect                 | -                      | 0.022                  |
| NJ        | Emission coefficient of junction  | _                      | 1                      |
| PRT       | Temerature coefficient for RDSW   | $\Omega \mu m$         | 0                      |
| TCJ       | Temperature coefficient of Cj   | $K^{-1}$               | 0                      |
| TCJSW     | Temperature coefficient of Cswj   | $K^{-1}$               | 0                      |
| TCJSWG    | Temperature coefficient of Cjswg  | $K^{-1}$               | 0                      |
| TNOM      | Nominal device temperature  | °C                     | Ambient<br>Temperature |
| TPB       | Temperature coefficient of Pb   | V/K                    | 0                      |
| TPBSW     | Temperature coefficient of Pbsw   | V/K                    | 0                      |

Table 2-99. BSIM3 Device Model Parameters

| Parameter          | Description                                       | Units                 | Default   |  |
|--------------------|---|-----------------------|-----------|--|
| TPBSWG             | Temperature coefficient of Pbswg                  | V/K                   | 0         |  |
| UA1                | Temperature coefficient for UA                    | m/V                   | 4.31e-09  |  |
| UB1                | Temperature coefficient for UB                    | $m^2/V^2$             | -7.61e-18 |  |
| UC1                | Temperature coefficient for UC                    | m/(°CV <sup>2</sup> ) | 0         |  |
| UTE                | Mobility temerature exponent                      | _                     | -1.5      |  |
| XTI                | Junction current temperature exponent coefficient | _                     | 3         |  |
| Voltage Parameters |   |                       |           |  |
| PB                 | Bulk p-n bottom potential                         | V                     | 1         |  |

## 2.3.20.6. Level 10 MOSFET Tables (BSIM-SOI)

For complete documentation of the BSIM-SOI model, see the users' manual for the BSIM-SOI, available for download at http://bsim.berkeley.edu/models/bsimsoi/. Xyce implements Version 3.2 of the BSIM-SOI, you will have to get the documentation from the FTP archive on the Berkeley site.

In addition to the parameters shown in table 2-100, the BSIM3SOI supports a vector parameter for the initial conditions. IC1 through IC5 may therefore be specified compactly as IC=<ic1>, <ic2>, <ic3>, <ic4>, <ic5>.

NOTE: Many BSIM SOI parameters listed in tables 2-100 and 2-101 as having default values of zero are actually replaced with internally computed defaults if not given. Specifying zero in your model card will override this internal computation. It is recommended that you only set model parameters that you are actually changing from defaults and that you not generate model cards containing default values from the tables.

Table 2-100, BSIM3 SOI Device Instance Parameters

| Parameter | Description  | Units            | Default |
|-----------|--|------------------|---------|
| BJTOFF    | BJT on/off flag  | logical<br>(T/F) | 0       |
| DEBUG     | BJT on/off flag  | logical<br>(T/F) | 0       |
| TNODEOUT  | Flag indicating external temp node   | logical<br>(T/F) | 0       |
| VLDEBUG   |  | logical<br>(T/F) | false   |
|           | Control Parameters   |                  |         |
| M         | Multiplier for M devices connected in parallel   |                  | 1       |
| SOIMOD    | SIO model selector,SOIMOD=0:<br>BSIMPD,SOIMOD=1: undefined model for PD and<br>FE,SOIMOD=2: ideal FD | _                | 0       |
|           | DC Parameters  |                  |         |
| VBSUSR    | Vbs specified by user  | V                | 0       |
|           | Geometry Parameters  |                  |         |
| AD        | Drain diffusion area   | m <sup>2</sup>   | 0       |
| AEBCP     | Substrate to body overlap area for bc prasitics  | $m^2$            | 0       |
| AGBCP     | Gate to body overlap area for bc parasitics  | $m^2$            | 0       |
| AS        | Source diffusion area  | $m^2$            | 0       |
| FRBODY    | Layout dependent body-resistance coefficient   | _                | 1       |
| L         | Channel length   | m                | 5e-06   |
| NBC       | Number of body contact isolation edge  |                  | 0       |
| NRB       | Number of squares in body  |                  | 1       |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |                  | 1       |

Table 2-100. BSIM3 SOI Device Instance Parameters

| Parameter | Description  | Units            | Default |
|-----------|--|------------------|---------|
| NRS       | Multiplier for RSH to yield parasitic resistance of source |                  | 1       |
| NSEG      | Number segments for width partitioning                     | _                | 1       |
| PD        | Drain diffusion perimeter                                  | m                | 0       |
| PDBCP     | Perimeter length for bc parasitics at drain side           | m                | 0       |
| PS        | Source diffusion perimeter                                 | m                | 0       |
| PSBCP     | Perimeter length for bc parasitics at source side          | m                | 0       |
| W         | Channel width  | m                | 5e-06   |
|           | RF Parameters  |                  |         |
| RGATEMOD  | Gate resistance model selector                             | _                | 0       |
|           | Temperature Parameters                                     |                  |         |
| CTH0      | Thermal capacitance  | F                | 0       |
| RTH0      | normalized thermal resistance                              | Ω                | 0       |
| TEMP      | Device temperature   | °C               | 27      |
|           | Voltage Parameters   |                  |         |
| IC1       | Initial condition on Vds                                   | V                | 0       |
| IC2       | Initial condition on Vgs                                   | V                | 0       |
| IC3       | Initial condition on Vbs                                   | V                | 0       |
| IC4       | Initial condition on Ves                                   | V                | 0       |
| IC5       | Initial condition on Vps                                   | V                | 0       |
| OFF       | Initial condition of no voltage drops accross device       | logical<br>(T/F) | false   |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| DELTAVOX  | The smoothing parameter in the Vox smoothing function | -     | 0       |
| DTOXCV    | Delta oxide thickness in meters in CapMod3            | m     | 0       |
| FNOIMOD   | Flicker noise model selector                          | _     | 1       |
| IGBMOD    | Flicker noise model selector                          | _     | 0       |
| IGCMOD    | Gate-channel tunneling current model selector         | -     | 0       |
| KB1       | Scaling factor for backgate charge                    | _     | 1       |
| NOIF      | Floating body excess noise ideality factor            | -     | 1       |
| NTNOI     | Thermal noise parameter                               | -     | 1       |
| POXEDGE   | Factor for the gate edge Tox                          | _     | 1       |
| RNOIA     | Thermal noise coefficient                             | _     | 0.577   |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| RNOIB     | Thermal noise coefficient  | _     | 0.37    |
| RSHG      | Gate sheet resistance  | _     | 0.1     |
| TNOIA     | Thermal noise parameter  | _     | 1.5     |
| TNOIB     | Thermal noise parameter  | _     | 3.5     |
| TNOIMOD   | Thermal noise model selector   | _     | 0       |
| VBS0FD    | Lower bound of built-in potential lowering for FD operation                                      | V     | 0.5     |
| VBS0PD    | Upper bound of built-in potential lowering for FD operation                                      | _     | 0       |
| VOXH      | The limit of Vox in gate current calculation   | _     | 0       |
| VTHO      | Threshold voltage  | _     | 0       |
|           | Bin Parameters   |       |         |
| LMAX      | Maximum channel length   | m     | 1       |
| LMIN      | Minimum channel length   | m     | 0       |
| WMAX      | Maximum channel width  | m     | 1       |
| WMIN      | Minimum channel width  | m     | 0       |
|           | Capacitance Parameters   |       |         |
| ACDE      | Exponetial coefficient for charge thickness in capmod = 3 for accumulation and depletion regions | m/V   | 1       |
| ASD       | Sorce/Drain bottom diffusion smoothing parameter   | _     | 0.3     |
| CF        | Firing field capacitance   | F/m   | 0       |
| CGDL      | Light-doped drain-gate region overlap capacitance  | F/m   | 0       |
| CGDO      | Non-LLD region drain-gate overlap capacitance per unit channel length                            | F/m   | 0       |
| CGEO      | Gate substrate overlap capacitance per unit channel length                                       | F/m   | 0       |
| CGSL      | Light-doped source-gate region overlap capacitance   | F/m   | 0       |
| CGSO      | Non-LLD region source-gate overlap capacitance per unit channel length                           | F/m   | 0       |
| CJSWG     | Source/grain gate sidewall junction capacitance per unit width                                   | F/m   | 1e-10   |
| СКАРРА    | Coefficient for lightly doped region overlap capacitance fireing field capacitance               | F/m   | 0.6     |
| CLC       | Constant term for short-channel model  | m     | 1e-08   |
| CLE       | Exponetial term for the short-channel model  |       | 0       |
| CSDESW    | Sorce/Drain sidewall fringing capacitance per unit length  | F/m   | 0       |
| CSDMIN    | Sorce/Drain bottom diffusion minimum capacitance   | V     | 0       |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description  | Units   | Default       |
|-----------|--|---|---------------|
| DELVT     | Threshold voltage adjust for C-V   | V   | 0             |
| DLBG      | Length offset fitting parameter for backgate charge                      | m   | 0             |
| DLC       | Length offset fitting parameter from C-V                                 | m   | 0             |
| DLCB      | Length offset fitting parameter for body charge                          | m   | 0             |
| DWC       | Width offset fitting parameter from C-V                                  | m   | 0             |
| FBODY     | Scaling factor for body charge   | _   | 1             |
| LDIF0     | Channel length dependency coefficient of diffusion capacitance           | _   | 1             |
| MJSWG     | Source/grain gate sidewall junction capacitance grading coeficient       | _   | 0.5           |
| MOIN      | Coefficient for the gate-bias dependent surface potential                | _   | 15            |
| NDIF      | Power coefficient of channel length dependency for diffusion capacitance | _   | -1            |
| NOFF      | CV parameter in Vgsteff,CV for weak to strong inversion                  | _   | 1             |
| PBSWG     | Source/drain gate sidewall junction built-in potential                   | V   | 0.7           |
| TT        | Diffusion capacitance transit time coefficient                           | S   | 1e-12         |
| VSDFB     | Sorce/Drain bottom diffusion capacitance flatband voltage                | V   | 0             |
| VSDTH     | Sorce/Drain bottom diffusion capacitance threshold voltage               | V   | 0             |
| XPART     | Charge partitioning rate flag  | _   | 0             |
|           | Control Parameters   |   |               |
| BINUNIT   | Binning unit selector  | _   | 1             |
| CAPMOD    | Flag for capacitance models  | _   | 2             |
| MOBMOD    | Mobility model selector  | _   | 1             |
| PARAMCHK  | Parameter value check  | _   | 0             |
| SHMOD     | Flag for self-heating,0-no self-heating,1-self-heating                   | _   | 0             |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature           | _   | 'NONE'        |
| VERSION   | Version number   | _   | '3.2'         |
|           | Current Parameters   |   |               |
| AIGC      | Parameter for Igc  | $(F/g)^{1/2}s$  | /m <b>V</b> / |
| AIGSD     | Parameter for Igs,d  | $\frac{(F/g)^{1/2}s/m\mathbf{V}}{(F/g)^{1/2}s/m\mathbf{V}}$ |               |
| BIGC      | Parameter for Igc  | $(F/g)^{1/2}$ s   |               |
| BIGSD     | Parameter for Igs,d  | $\frac{(F/g)^{1/2}s/m\nabla}{(F/g)^{1/2}s/m\nabla}$         |               |
| CIGC      | Parameter for Igc  | $V^{-1}$  | 0             |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description  | Units                | Default |
|-----------|--|----------------------|---------|
| CIGSD     | Parameter for Igs,d  | $V^{-1}$             | 0       |
| DLCIG     | Delta L for Ig model   | $V^{-1}$             | 0       |
| NIGC      | Parameter for Igc slope  | _                    | 1       |
| PIGCD     | Parameter for Igc partition  | _                    | 1       |
|           | DC Parameters  |                      |         |
| A0        | Bulk charge effect coefficient for channel length  | _                    | 1       |
| A1        | First non-saturation effect parameter  | $V^{-1}$             | 0       |
| A2        | Second non-saturation factor   | _                    | 1       |
| AELY      | Channel length dependency of early voltage for bipolar current                                 | $\mathrm{Vm^{-1}}$   | 0       |
| AGIDL     | GIDL constant  | $\Omega^{-1}$        | 0       |
| AGS       | Gate-bias coefficient of abulk   | $V^{-1}$             | 0       |
| AHLI      | High level injection parameter for bipolar current   | _                    | 0       |
| ALPHA0    | First parameter of impact-ionization current   | m/V                  | 0       |
| В0        | Bulk charge effect coefficient for channel width   | m                    | 0       |
| B1        | Bulk charge effect offset  | m                    | 0       |
| BETA0     | Second parameter of impact-ionization current  | V                    | 0       |
| BETA1     | Second Vds dependent parameter of impact ionizatin current                                     | _                    | 0       |
| BETA2     | Third Vds dependent parameter of impact ionizatin current                                      | V                    | 0.1     |
| BGIDL     | GIDL exponential coefficient   | $\mathrm{Vm}^{-1}$   | 0       |
| CDSC      | Drain/source to channel coupling capacitance   | F/m <sup>2</sup>     | 0.00024 |
| CDSCB     | Body-bias sensitivity of CDSC  | F/(Vm <sup>2</sup> ) | 0       |
| CDSCD     | Drain-bias sensitivity of CDSC   | F/(Vm <sup>2</sup> ) | 0       |
| CIT       | Interface trap capacitance   | F/m <sup>2</sup>     | 0       |
| DELTA     | Effective Vds parameter  | V                    | 0.01    |
| DROUT     | L-depedance Coefficient of the DIBL correction parameter in Rout                               | -                    | 0.56    |
| DSUB      | DIBL coefficient exponent in subthreshhold region  | _                    | 0       |
| DVT0      | First coefficient of short-channel effect effect on threshold voltage                          | -                    | 2.2     |
| DVT0W     | First coefficient of narrow-width effect effect on threshold voltage for small channel length  | $\mathrm{m}^{-1}$    | 0       |
| DVT1      | Second coefficient of short-channel effect effect on threshold voltage                         | _                    | 0.53    |
| DVT1W     | Second coefficient of narrow-width effect effect on threshold voltage for small channel length | $\mathrm{m}^{-1}$    | 5.3e+06 |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description   | Units              | Default  |
|-----------|---|--------------------|----------|
| DVT2      | Body-bias coefficient of short-channel effect effect on threshold voltage                         | $V^{-1}$           | -0.032   |
| DVT2W     | Body-bias coefficient of narrow-width effect effect on threshold voltage for small channel length | $V^{-1}$           | -0.032   |
| DWB       | Coefficient of substrate body bias dependence of Weff   | m/V <sup>1/2</sup> | 0        |
| DWBC      | Width offset for body contact isolation edge  | m                  | 0        |
| DWG       | Coefficient of gate depedence of Weff   | m/V <sup>1/2</sup> | 0        |
| ESATII    | Saturation channel electric field for impact ionization current                                   | $Vm^{-1}$          | 1e+07    |
| ETA0      | DIBL coefficient in subthreshold region   | _                  | 0.08     |
| ETAB      | Body-bias coefficient for the subthreshold DIBL effect  | $V^{-1}$           | -0.07    |
| FBJTII    | Fraction of bipolar current affecting the impact ionization                                       | _                  | 0        |
| ISBJT     | BJT injection saturation current  | A/m <sup>2</sup>   | 1e-06    |
| ISDIF     | BOdy to source/drain injection saturation current   | A/m <sup>2</sup>   | 0        |
| ISREC     | Recombinatin in depletion saturation current  | A/m <sup>2</sup>   | 1e-05    |
| ISTUN     | Reverse tunneling saturation current  | A/m <sup>2</sup>   | 0        |
| K1        | First-order body effect coefficient   | $V^{1/2}$          | 0        |
| K1W1      | First body effect width depenent parameter  | m                  | 0        |
| K1W2      | Second body effect width depenent parameter   | m                  | 0        |
| K2        | second-order body effect coefficient  | _                  | 0        |
| K3        | Narrow width coefficient  | _                  | 0        |
| K3B       | Body effect coefficient of K3   | $V^{-1}$           | 0        |
| KETA      | Body-bias coefficient of bulk charge effect   | $V^{-1}$           | -0.6     |
| KETAS     | Surface potential adjustment for bulk charge effect   | V                  | 0        |
| LBJT0     | Reference channel length for bipolar current  | m                  | 2e-07    |
| LII       | Channel length dependent parameter at threshold for impact ionization current                     | _                  | 0        |
| LINT      | Length of offset fiting parameter from I-V without bias   | m                  | 0        |
| LN        | Electron/hole diffusion length  | m                  | 2e-06    |
| NBJT      | Power coefficient of channel length   | _                  | 1        |
| NDIODE    | Diode non-ideality factor   | _                  | 1        |
| NFACTOR   | Subthreshold swing factor   | _                  | 1        |
| NGATE     | Poly gate doping concentration  | $\mathrm{cm}^{-3}$ | 0        |
| NGIDL     | GIDL Vds enhancement coefficient  | V                  | 1.2      |
| NLX       | Lateral non-uniform doping parameter  | m                  | 1.74e-07 |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description  | Units            | Default  |
|-----------|--|------------------|----------|
| NRECF0    | Recombination non-ideality factor at foward bias                                 | _                | 2        |
| NRECRO    | Recombination non-ideality factor at reverse bias                                | _                | 10       |
| NTUN      | Reverse tunneling non-ideality factor  | _                | 10       |
| PCLM      | Channel length modulation parameter  | _                | 1.3      |
| PDIBLC1   | First output resistance DIBL effect correction parameter                         | -                | 0.39     |
| PDIBLC2   | Second output resistance DIBL effect correction parameter                        | _                | 0.0086   |
| PDIBLCB   | Body effect coefficient of DIBL correction parameter                             | $V^{-1}$         | 0        |
| PRWB      | Body effect coefficient of RDSW  | $V^{-1/2}$       | 0        |
| PRWG      | Gate-bias effect coefficient of RDSW   | $V^{-1}$         | 0        |
| PVAG      | Gate dependence of early voltage   | _                | 0        |
| RBODY     | Intrinsic body contact sheet resistance  | $\Omega/\Box$    | 0        |
| RBSH      | Intrinsic body contact sheet resistance  | $\Omega/\square$ | 0        |
| RDSW      | Parasitic resistance per unit width  | $\Omega \mu m$   | 100      |
| RHALO     | Body halo sheet resistance   | $\Omega/m$       | 1e+15    |
| SIIO      | First Vgs dependent parameter of impact ionizatin current                        | $V^{-1}$         | 0.5      |
| SII1      | Second Vgs dependent parameter of impact ionizatin current                       | $V^{-1}$         | 0.1      |
| SII2      | Third Vgs dependent parameter of impact ionizatin current                        | -                | 0        |
| SIID      | Vds dependent parameter of drain saturation voltage for impact ionizatin current | $V^{-1}$         | 0        |
| TII       | Temperature dependent parameter for impact ionization current                    | _                | 0        |
| UA        | First-order mobility degradation coefficient                                     | m/V              | 2.25e-09 |
| UB        | First-order mobility degradation coefficient                                     | $m^2/V^2$        | 5.87e-19 |
| UC        | Body effect of mobility degridation coefficient                                  | m/V <sup>2</sup> | 0        |
| VABJT     | Early voltage for bipolar current  | V                | 10       |
| VBM       | Maximum applied body-bias in threshold voltage calculation                       | V                | -3       |
| VDSATIIO  | Normal drain saturatio voltage at threshold for impact ionization current        | V                | 0.9      |
| VOFF      | Offset voltage in the subthreshold region at large W and L                       | V                | -0.08    |
| VREC0     | Voltage dependent parameter for recombination current                            | V                | 0        |
| VSAT      | Saturation velocity at temp = TNOM   | m/s              | 80000    |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description  | Units             | Default |
|-----------|--|-------------------|---------|
| VTH0      | Threshold voltage at $Vbs = 0$ for large $L$         | V                 | 0       |
| VTUN0     | Voltage dependent parameter for tunneling current    | V                 | 0       |
| WO        | Narrow-width paameter                                | m                 | 2.5e-06 |
| WINT      | Width-offset fitting parameter from I-V without bias | m                 | 0       |
| WR        | Width offset from Weff for Rds Calculation           | -                 | 1       |
|           | Dependency Parameters                                |                   |         |
| LA0       | Length dependence of A0                              | m                 | 0       |
| LA1       | Length dependence of A1                              | m/V               | 0       |
| LA2       | Length dependence of A2                              | m                 | 0       |
| LACDE     | Length dependence of ACDE                            | m <sup>2</sup> /V | 0       |
| LAELY     | Length dependence of AELY                            | V                 | 0       |
| LAGIDL    | Length dependence of AGIDL                           | m/Ω               | 0       |
| LAGS      | Length dependence of AGS                             | m/V               | 0       |
| LAHLI     | Length dependence of AHLI                            | m                 | 0       |
| LAIGC     | Length dependence of AIGC                            | $(F/g)^{1/2}$ sı  | m/m0V   |
| LAIGSD    | Length dependence of AIGSD                           | $(F/g)^{1/2}$ sı  | m/m0V   |
| LALPHA0   | Length dependence of ALPHA0                          | m <sup>2</sup> /V | 0       |
| LALPHAGB1 | Length dependence of ALPHAGB1                        | m/V               | 0       |
| LALPHAGB2 | Length dependence of ALPHAGB2                        | m/V               | 0       |
| LAT       | Length dependence of AT                              | m <sup>2</sup> /s | 0       |
| LB0       | Length dependence of B0                              | $m^2$             | 0       |
| LB1       | Length dependence of B1                              | m <sup>2</sup>    | 0       |
| LBETA0    | Length dependence of BETA0                           | Vm                | 0       |
| LBETA1    | Length dependence of BETA1                           | m                 | 0       |
| LBETA2    | Length dependence of BETA2                           | Vm                | 0       |
| LBETAGB1  | Length dependence of BETAGB1                         | m/V <sup>2</sup>  | 0       |
| LBETAGB2  | Length dependence of BETAGB2                         | m/V <sup>2</sup>  | 0       |
| LBGIDL    | Length dependence of BGIDL                           | V                 | 0       |
| LBIGC     | Length dependence of BIGC                            | $(F/g)^{1/2}$ sı  | m/ı@V   |
| LBIGSD    | Length dependence of BIGSD                           | $(F/g)^{1/2}$ sı  | m/ıtûV  |
| LCDSC     | Length dependence of CDSC                            | F/m               | 0       |
| LCDSCB    | Length dependence of CDSCB                           | F/(Vm)            | 0       |
| LCDSCD    | Length dependence of CDSCD                           | F/(Vm)            | 0       |
| LCGDL     | Length dependence of CGDL                            | F                 | 0       |
| LCGSL     | Length dependence of CGSL                            | F                 | 0       |
| LCIGC     | Length dependence of CIGC                            | m/V               | 0       |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                 | Units           | Default |
|-----------|-----------------------------|-----------------|---------|
| LCIGSD    | Length dependence of CIGSD  | m/V             | 0       |
| LCIT      | Length dependence of CIT    | F/m             | 0       |
| LCKAPPA   | Length dependence of CKAPPA | F               | 0       |
| LDELTA    | Length dependence of DELTA  | Vm              | 0       |
| LDELVT    | Length dependence of DELVT  | Vm              | 0       |
| LDROUT    | Length dependence of DROUT  | m               | 0       |
| LDSUB     | Length dependence of DSUB   | m               | 0       |
| LDVT0     | Length dependence of DVT0   | m               | 0       |
| LDVT0W    | Length dependence of DVT0W  | _               | 0       |
| LDVT1     | Length dependence of DVT1   | m               | 0       |
| LDVT1W    | Length dependence of DVT1W  | _               | 0       |
| LDVT2     | Length dependence of DVT2   | m/V             | 0       |
| LDVT2W    | Length dependence of DVT2W  | m/V             | 0       |
| LDWB      | Length dependence of DWB    | $m^2/V^{1/2}$   | 0       |
| LDWG      | Length dependence of DWG    | $m^2/V^{1/2}$   | 0       |
| LESATII   | Length dependence of ESATII | V               | 0       |
| LETA0     | Length dependence of ETA0   | m               | 0       |
| LETAB     | Length dependence of ETAB   | m/V             | 0       |
| LFBJTII   | Length dependence of FBJTII | m               | 0       |
| LISBJT    | Length dependence of ISBJT  | A/m             | 0       |
| LISDIF    | Length dependence of ISDIF  | A/m             | 0       |
| LISREC    | Length dependence of ISREC  | A/m             | 0       |
| LISTUN    | Length dependence of ISTUN  | A/m             | 0       |
| LK1       | Length dependence of K1     | $V^{1/2}$ m     | 0       |
| LK1W1     | Length dependence of K1W1   | m <sup>2</sup>  | 0       |
| LK1W2     | Length dependence of K1W2   | m <sup>2</sup>  | 0       |
| LK2       | Length dependence of K2     | m               | 0       |
| LK3       | Length dependence of K3     | m               | 0       |
| LK3B      | Length dependence of K3B    | m/V             | 0       |
| LKB1      | Length dependence of KB1    | m               | 0       |
| LKETA     | Length dependence of KETA   | m/V             | 0       |
| LKETAS    | Length dependence of KETAS  | Vm              | 0       |
| LKT1      | Length dependence of KT1    | Vm              | 0       |
| LKT1L     | Length dependence of KT1L   | Vm <sup>2</sup> | 0       |
| LKT2      | Length dependence of KT2    | m               | 0       |
| LLBJT0    | Length dependence of LBJT0  | $m^2$           | 0       |
|           |                             |                 |         |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                  | Units                 | Default |
|-----------|------------------------------|-----------------------|---------|
| LLII      | Length dependence of LII     | m                     | 0       |
| LMOIN     | Length dependence of MOIN    | m                     | 0       |
| LNBJT     | Length dependence of NBJT    | m                     | 0       |
| LNCH      | Length dependence of NCH     | m/cm <sup>3</sup>     | 0       |
| LNDIF     | Length dependence of NDIF    | m                     | 0       |
| LNDIODE   | Length dependence of NDIODE  | m                     | 0       |
| LNFACTOR  | Length dependence of NFACTOR | m                     | 0       |
| LNGATE    | Length dependence of NGATE   | m/cm <sup>3</sup>     | 0       |
| LNGIDL    | Length dependence of NGIDL   | Vm                    | 0       |
| LNIGC     | Length dependence of NIGC    | m                     | 0       |
| LNLX      | Length dependence of NLX     | $m^2$                 | 0       |
| LNOFF     | Length dependence of NOFF    | m                     | 0       |
| LNRECF0   | Length dependence of NRECF0  | m                     | 0       |
| LNRECR0   | Length dependence of NRECR0  | m                     | 0       |
| LNSUB     | Length dependence of NSUB    | m/cm <sup>3</sup>     | 0       |
| LNTRECF   | Length dependence of NTRECF  | m                     | 0       |
| LNTRECR   | Length dependence of NTRECR  | m                     | 0       |
| LNTUN     | Length dependence of NTUN    | m                     | 0       |
| LPCLM     | Length dependence of PCLM    | m                     | 0       |
| LPDIBLC1  | Length dependence of PDIBLC1 | m                     | 0       |
| LPDIBLC2  | Length dependence of PDIBLC2 | m                     | 0       |
| LPDIBLCB  | Length dependence of PDIBLCB | m/V                   | 0       |
| LPIGCD    | Length dependence of PIGCD   | m                     | 0       |
| LPOXEDGE  | Length dependence of POXEDGE | m                     | 0       |
| LPRT      | Length dependence of PRT     | $\Omega \mu$ m m      | 0       |
| LPRWB     | Length dependence of PRWB    | m/V <sup>1/2</sup>    | 0       |
| LPRWG     | Length dependence of PRWG    | m/V                   | 0       |
| LPVAG     | Length dependence of PVAG    | m                     | 0       |
| LRDSW     | Length dependence of RDSW    | $\Omega \mu$ m m      | 0       |
| LSII0     | Length dependence of SII0    | m/V                   | 0       |
| LSII1     | Length dependence of SII1    | m/V                   | 0       |
| LSII2     | Length dependence of SII2    | m                     | 0       |
| LSIID     | Length dependence of SIID    | m/V                   | 0       |
| LU0       | Length dependence of U0      | m/(Vcm <sup>2</sup> s | s) 0    |
| LUA       | Length dependence of UA      | m <sup>2</sup> /V     | 0       |
| LUA1      | Length dependence of UA1     | m <sup>2</sup> /V     | 0       |
|           | <u> </u>                     |                       |         |

Table 2-101. BSIM3 SOI Device Model Parameters

| LUB         Length dependence of UB         m³/V²         0           LUBB1         Length dependence of UBI         m³/V²         0           LUCC         Length dependence of UCI         m²/V²         0           LUCI         Length dependence of UCI         m²/V²CV²)         0           LUCI         Length dependence of UCI         m²/V²CV²)         0           LUDITE         Length dependence of UCI         m²/V²CV²)         0           LVABAT         Length dependence of VABIT         Vm         0           LVDSATIIO         Length dependence of VSATIIIO         Vm         0           LVDSAT         Length dependence of VSAT         m²/s         0           LVSSAT         Length dependence of VSDFB         Vm         0           LVSSTB         Length dependence of VSDFB         Vm         0           LVSSDTH         Length dependence of VSDTH         Vm         0           LVSDTH         Length dependence of VSDTH         Vm         0           LVTUNO         Length dependence of VTDNO         Vm         0           LVTTINO         Length dependence of WR         m         0           LLWB         Length dependence of WR         m         0  | Parameter | Description                       | Units                | Default            |
|--|-----------|-----------------------------------|----------------------|--------------------|
| LUCC   | LUB       | Length dependence of UB           | $m^3/V^2$            | 0                  |
| Length dependence of UC1   | LUB1      | Length dependence of UB1          | $m^3/V^2$            | 0                  |
| LUTE         Length dependence of UTE         m         0           LVABJT         Length dependence of VABJT         Vm         0           LVDSATIIO         Length dependence of VDSATHO         Vm         0           LVDFF         Length dependence of VOFF         Vm         0           LVDFF         Length dependence of VSECO         Vm         0           LVSAT         Length dependence of VSDFB         Vm         0           LVSDFB         Length dependence of VSDFB         Vm         0           LVSDTH         Length dependence of VSDFB         Vm         0           LVYDTON         Length dependence of VTHO         Vm         0           LWT         Length dependence of VTUNO         Vm         0           LWR         Length dependence of WR         m         0           LWR         Length dependence of XDF         m         0           LXBJT         Length dependence of XDF         m         0           LXRCRG1         Lengt  | LUC       | Length dependence of UC           | $m^2/V^2$            | 0                  |
| Length dependence of VABJT $Vm = 0$ LVDSATIIO Length dependence of VDSATIIO $Vm = 0$ LVDSATIIO Length dependence of VDFF $Vm = 0$ LVDFF Length dependence of VBECO $Vm = 0$ LVDSAT Length dependence of VSAT $m^2/s = 0$ LVDSAT Length dependence of VSAT $m^2/s = 0$ LVDSDTB Length dependence of VSDFB $Vm = 0$ LVDSDTH Length dependence of VSDTH $Vm = 0$ LVDTHO Length dependence of VTINO $Vm = 0$ LVTINO Length dependence of VTINO $Vm = 0$ LWR Length dependence of VTINO $Vm = 0$ LWR Length dependence of WR $Vm = 0$ LWR Length dependence of WR $Vm = 0$ LWR Length dependence of WR $Vm = 0$ LWR Length dependence of WB $Vm = 0$ LWRCRGI Length dependence of XBIT $Vm = 0$ LWRCRGI Length dependence of XRCRGI $Vm = 0$ LWRTON Length dependence of XRCRGI $Vm = 0$ PAO Cross-term dependence of ACDE $Vm = 0$ PAO Cross-term dependence of ACDE $Vm = 0$ PAO Cross-term dependence of ACDE $Vm = 0$ PAGS Cross-term dependence of AGDE $Vm = 0$ PAGS Cross-term dependence of AGDE $Vm = 0$ PAGS Cross-term dependence of AGDE $Vm = 0$ PAGS Cross-term dependence of AGDI $Vm = 0$ PAGS Cross-term dependence of   | LUC1      | Length dependence of UC1          | m <sup>2</sup> /(°CV | <sup>2</sup> ) 0   |
| EVDSATIIO         Length dependence of VDSATIIO         Vm         0           LVOFF         Length dependence of VOFF         Vm         0           LVRECO         Length dependence of VRECO         Vm         0           LVSAT         Length dependence of VSAT         m²/s         0           LVSDFB         Length dependence of VSDFB         Vm         0           LVSDFB         Length dependence of VSDTH         Vm         0           LVSDFB         Length dependence of VSDFB         Vm         0           LVSTBO         Length dependence of VTHO         Vm         0           LVTHO         Length dependence of VTUNO         Vm         0           LAW         Length dependence of WR         m         0           LLWB         Length dependence of XDIF         m         0           LXZ         Length dependence of XRCRG1         m         0           LXX         Length dependence of XRCRG2         m         0           LXX   | LUTE      | Length dependence of UTE          | m                    | 0                  |
| LVOFF         Length dependence of VOFF         Vm         0           LVRECO         Length dependence of VRECO         Vm         0           LVSAT         Length dependence of VRECO         Vm         0           LVSDFB         Length dependence of VSDFB         Vm         0           LVSDTH         Length dependence of VSDTH         Vm         0           LVTH0         Length dependence of VTHO         Vm         0           LVTUNO         Length dependence of VTUNO         Vm         0           LWR         Length dependence of WR         m         0           LWR         Length dependence of WR         m         0           LXBJT         Length dependence of XBT         m         0           LXJ         Length dependence of XDIF         m         0           LXRCRGI         Length dependence of XRCRGI         m         0           LXRCRGI         Leng  | LVABJT    | Length dependence of VABJT        | Vm                   | 0                  |
| LURECO Length dependence of VRECO $Vm = 0$ LUSSAT Length dependence of VSAT $m^2/s = 0$ LUSSDFB Length dependence of VSDFB $Vm = 0$ LUSDFB Length dependence of VSDFB $Vm = 0$ LUSDTH Length dependence of VSDTH $Vm = 0$ LUVTHO Length dependence of VTHO $Vm = 0$ LUVTUNO Length dependence of VTUNO $Vm = 0$ LUVTUNO Length dependence of WO $Vm = 0$ LURE Length dependence of WR $Vm = 0$ LURE Length dependence of WR $Vm = 0$ LURE Length dependence of WR $Vm = 0$ LUXBJT Length dependence of XBJT $Vm = 0$ LUXJ Length dependence of XDIF $Vm = 0$ LUXJ Length dependence of XJ $Vm = 0$ LUXRCRGG1 Length dependence of XRCRGI $Vm = 0$ LUXRCRGG2 Length dependence of XRCRGI $Vm = 0$ LUXRUCK Length dependence of XRCRGI $Vm = 0$ LUXTUN Length dependence of XTUN $Vm = 0$ PADO Cross-term dependence of XTUN $Vm = 0$ PADO Cross-term dependence of AI $Vm = 0$ PADO Cross-term dependence of AIDL $Vm = 0$ PADO Cross-term dependence of AIDL $Vm = 0$ PAGGS Cross-term dependence of AGDDL $Vm$  | LVDSATII0 | Length dependence of VDSATII0     | Vm                   | 0                  |
| LOWSAT         Length dependence of VSAT         m²/s         0           LOWSDFB         Length dependence of VSDFB         Vm         0           LOWSDTH         Length dependence of VSDTH         Vm         0           LOWTHO         Length dependence of VTHO         Vm         0           LAVTUNO         Length dependence of VTUNO         Vm         0           LAWO         Length dependence of WO         m²         0           LAWO         Length dependence of WR         m         0           LAWR         Length dependence of WR         m         0           LAWR         Length dependence of XBJT         m         0           LAWA         Length dependence of XJ         m²         0           LAWR         Length dependence of XZCRGI         m         0           LAWRCRGI         Length dependence of XRCRGI         m         0           LAWRCRGI  | LVOFF     | Length dependence of VOFF         | Vm                   | 0                  |
| LVSDFB         Length dependence of VSDTH         Vm         0           LVSDTH         Length dependence of VSDTH         Vm         0           LVTHO         Length dependence of VTHO         Vm         0           LVTUNO         Length dependence of VTUNO         Vm         0           LWG         Length dependence of WO         m²         0           LWR         Length dependence of WR         m         0           LXBJT         Length dependence of XBJT         m         0           LXJ         Length dependence of XJI         m²         0           LXZ         Length dependence of XRCRG1         m         0           LXRCRG2         Length dependence of XRCRG2         m         0           LXREC         Length dependence of XREC         m         0           LXTUN         Length dependence of XTUN         m         0           PAO         Cross-term dependence of A0         m²         0           PAI         Cross-term dependence of A1         m²/V         0           PAI         Cross-term dependence of A2         m²         0           PAI         Cross-term dependence of ACDE         m³/V         0           PAGDE         Cross-term depen  | LVREC0    | Length dependence of VREC0        | Vm                   | 0                  |
| LVSDTH         Length dependence of VSDTH         Vm         0           LVTHO         Length dependence of VTHO         Vm         0           LVTUNO         Length dependence of VTUNO         Vm         0           LWO         Length dependence of WO         m²         0           LWR         Length dependence of WR         m         0           LWBJT         Length dependence of XBJT         m         0           LXJ         Length dependence of XDIF         m         0           LXJ         Length dependence of XRCRG1         m         0           LXRCRG1         Length dependence of XRCRG2         m         0           LXRCRG2         Length dependence of XRCRG2         m         0           LXREC         Length dependence of XRCRG         m         0           LXTUN         Length dependence of XTUN         m         0           PAO         Cross-term dependence of AO         m²         0           PAO         Cross-term dependence of AI         m²/V         0           PAO         Cross-term dependence of ACDE         m³/V         0           PAO         Cross-term dependence of ACDE         m³/V         0           PACDE         Cross-term  | LVSAT     | Length dependence of VSAT         | m <sup>2</sup> /s    | 0                  |
| Length dependence of VTH0 $$ Vm $$ 0 $$ Length dependence of VTUN0 $$ Vm $$ 0 $$ LWO $$ Length dependence of WO $$ m² $$ 0 $$ LWR $$ Length dependence of WO $$ m° $$ 0 $$ LWR $$ Length dependence of WR $$ m $$ 0 $$ LXBJT $$ Length dependence of XBJT $$ m $$ 0 $$ LXDIF $$ Length dependence of XDIF $$ m $$ 0 $$ LXZJ $$ Length dependence of XDIF $$ m $$ 0 $$ LXRCRG1 $$ Length dependence of XJ $$ m² $$ 0 $$ LXRCRG1 $$ Length dependence of XRCRG1 $$ m $$ 0 $$ LXRCRG2 $$ Length dependence of XRCRG2 $$ m $$ 0 $$ LXRCRG2 $$ Length dependence of XREC $$ m $$ 0 $$ LXTUN $$ Length dependence of XTUN $$ m $$ 0 $$ PAO $$ Cross-term dependence of A0 $$ m² $$ 0 $$ PAO $$ Cross-term dependence of A1 $$ m²/V $$ 0 $$ PAC2 $$ Cross-term dependence of A2 $$ m² $$ 0 $$ PACDE $$ Cross-term dependence of ACDE $$ m³/V $$ 0 $$ PAGIDL $$ Cross-term dependence of AGIDL $$ m²/Q $$ 0 $$ PAGIS $$ Cross-term dependence of AGIDL $$ m²/Q $$ 0 $$ PAGIS $$ Cross-term dependence of AGIDL $$ m²/V $$ 0 $$ PAGIGC $$ Cross-term dependence of AGIDL $$ m²/V $$ 0 $$ PAGIGC $$ Cross-term dependence of AGIDL $$ m²/V $$ 0 $$ PAGIGC $$ Cross-term dependence of AGIDL $$ m²/V $$ 0 $$ PAGIGC $$ Cross-term dependence of AGIDL $$ m²/V $$ 0 $$ PAGIGC $$ Cross-term dependence of AGIDL $$ m²/V $$ 0 $$ PAGIGC $$ Cross-term dependence of AGIDD $$ (F/g) $$ 1/2 sm²/b m/V PAGIGSD $$ Cross-term dependence of AGIDD $$ (F/g) $$ 1/2 sm²/b m/V PAGIGSD $$ Cross-term dependence of AGIDD $$ m³/V $$ 0 $$ PAGIGCD $$ Cross-term dependence of AGIDD $$ m³/V $$ 0 $$ PAGIGCD $$ Cross-term dependence of AGIDD $$ m³/V $$ 0 $$ PAGIGCD $$ Cross-term dependence of AGIDD $$ m³/V $$ 0 $$ PAGIGCD $$ Cross-term dependence of AGIDD $$ m³/V $$ 0 $$ PAGIDHAO $$ Cross-term dependence of ALPHAO $$ m³/V $$ 0 $$ PAGIDHAO $$ Cross-term dependence of ALPHAO $$ m³/V $$ 0 $$ PAGIDHAO $$ Cross-term dependence of ALPHAO $$ m³/V $$ 0 $$ PAGIDHAO $$ Cross-term dependence of  | LVSDFB    | Length dependence of VSDFB        | Vm                   | 0                  |
| LUTUNO Length dependence of VTUNO $Vm$ 0 Length dependence of WO $m^2$ 0 LWR Length dependence of WR $m$ 0 LXBJT Length dependence of XBJT $m$ 0 LXLXBJT Length dependence of XBJT $m$ 0 LXLXBJT Length dependence of XDIF $m$ 0 LXLXJ Length dependence of XJ $m^2$ 0 LXRCRGI Length dependence of XJ $m^2$ 0 LXRCRGI Length dependence of XRCRGI $m$ 0 LXRCRGI Length dependence of XREC $m$ 0 LXRUN Length dependence of XTUN $m$ 0 PAO Cross-term dependence of AO $m^2$ 0 PAI Cross-term dependence of AI $m^2/V$ 0 PAI Cross-term dependence of A2 $m^2$ 0 PAILY Cross-term dependence of ACDE $m^3/V$ 0 PAGIDL Cross-term dependence of AGDL $m^2/Q$ 0 PAGIDL Cross-term dependence of AGIDL $m^2/Q$ 0 PAGIDL Cross-term dependence of AGIDL $m^2/Q$ 0 PAGIDL Cross-term dependence of AHLI $m^2$ 0 PAGIDL Cross-term dependence of AHLI $m^2$ 0 PAGIDL Cross-term dependence of AGIDL $m^2/Q$ 0 PAGIS Cross-term dependence of AGIDL $m^2/Q$ 0 PAGIS Cross-term dependence of AGIDL $m^2/Q$ 0 PAGISD Cross-term dependence of AGIDL $m^$ | LVSDTH    | Length dependence of VSDTH        | Vm                   | 0                  |
| Length dependence of W0 m² 0  LWR Length dependence of WR m 0  LXBJT Length dependence of XBJT m 0  LXDIF Length dependence of XDIF m 0  LXJ Length dependence of XJ m² 0  LXRCRG1 Length dependence of XRCRG1 m 0  LXRCRG2 Length dependence of XRCRG2 m 0  LXTUN Length dependence of XTUN m 0  PA0 Cross-term dependence of A0 m² 0  PA1 Cross-term dependence of A1 m²/V 0  PA2 Cross-term dependence of A2 m² 0  PAGGDE Cross-term dependence of ACDE m³/V 0  PAGGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGGS Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAIGDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGGS Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAIGS Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAIGSD Cross-term dependence of AIDC (F/g) $^{1/2}$ sm²/ $\Omega$ mV  PAIGSD Cross-term dependence of AIGC m³/ $\Omega$ 0  PAIGSD Cross-term dependence of AIGC m³/ $\Omega$ 0  PAIGSD Cross-term dependence of AIGC m³/ $\Omega$ 0  PAIGSD Cross-term dependence of AIGCD m³/ $\Omega$ 0  PAIGSD Cross-term dependence of AIGCD m³/ $\Omega$ 0  | LVTH0     | Length dependence of VTH0         | Vm                   | 0                  |
| LWR Length dependence of WR m 0  LXBJT Length dependence of XBJT m 0  LXDIF Length dependence of XDIF m 0  LXJ Length dependence of XDIF m 0  LXRCRG1 Length dependence of XRCRG1 m 0  LXRCRG2 Length dependence of XRCRG2 m 0  LXTUN Length dependence of XRCRG2 m 0  LXTUN Length dependence of XTUN m 0  PA0 Cross-term dependence of A0 m² 0  PA1 Cross-term dependence of A1 m²/V 0  PA2 Cross-term dependence of A2 m² 0  PA2 Cross-term dependence of ACDE m³/V 0  PAGIDL Cross-term dependence of ACDE m³/V 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AHLI m² 0  PAGIDL Cross-term dependence of ALPHAOBI m²/V 0  | LVTUN0    | Length dependence of VTUN0        | Vm                   | 0                  |
| LXBJT Length dependence of XBJT m 0  LXDIF Length dependence of XDIF m 0  LXJ Length dependence of XJ m² 0  LXRCRG1 Length dependence of XRCRG1 m 0  LXRCRG2 Length dependence of XRCRG2 m 0  LXREC Length dependence of XREC m 0  LXTUN Length dependence of XTUN m 0  PAO Cross-term dependence of A0 m² 0  PA1 Cross-term dependence of A1 m²/V 0  PA2 Cross-term dependence of A2 m² 0  PA2 Cross-term dependence of A2 m² 0  PA2 Cross-term dependence of ACDE m³/V 0  PA2 Cross-term dependence of ACDE m³/V 0  PA2 Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGS Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIGC Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIGC Cross-term dependence of AIDC (F/g) $\Omega$ -  | LW0       | Length dependence of W0           | $m^2$                | 0                  |
| LENDIF Length dependence of XDIF m 0  LEXT Length dependence of XJ m² 0  LEXRCRG1 Length dependence of XRCRG1 m 0  LEXRCRG2 Length dependence of XRCRG2 m 0  LEXREC Length dependence of XREC m 0  LEXTUN Length dependence of XTUN m 0  PAO Cross-term dependence of AO m² 0  PAO Cross-term dependence of AI m²/V 0  PAO Cross-term dependence of AI m²/V 0  PACDE Cross-term dependence of ACDE m³/V 0  PACDE Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIS Cross-term dependence of AIGC m²/ $\Omega$ 0  PAGIS Cross-term dependence of AIGC m³/ $\Omega$ 0  PAGIS Cross-term dependence of AIGC m³/ $\Omega$ 0  PAGIS Cross-term dependence of AIGSD m³/ $\Omega$ 0  PAGIS Cross-term dependence of AIGSD m³/ $\Omega$ 0  | LWR       | Length dependence of WR           | m                    | 0                  |
| LENGTH dependence of XJ $\rm m^2$ 0 LENGTH dependence of XRCRG1 $\rm m$ 0 LEXRCRG2 Length dependence of XRCRG2 $\rm m$ 0 LEXRCRG2 Length dependence of XRCRG2 $\rm m$ 0 LEXTUREC Length dependence of XREC $\rm m$ 0 LEXTUREC Length dependence of XTUN $\rm m$ 0 PAO Cross-term dependence of AO $\rm m^2$ 0 PAO Cross-term dependence of AI $\rm m^2/V$ 0 PAO PAO Cross-term dependence of AI $\rm m^2/V$ 0 PAO PAO Cross-term dependence of A2 $\rm m^2$ 0 PAO PAO Cross-term dependence of ACDE $\rm m^3/V$ 0 PAO PAO PAO Cross-term dependence of ACDE $\rm m^3/V$ 0 PAO PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO CROSS-term dependence of AGIDL $\rm m^2/Q$ 0 PAO PAO CROSS-term dependence of AHLI $\rm m^2$ 0 PAO PAO CROSS-term dependence of AHLI $\rm m^2$ 0 PAO PAO CROSS-term dependence of AIGC $\rm (F/g)^{1/2} sm^2 fmV$ PAO PAO CROSS-term dependence of AIGSD $\rm m^3/V$ 0 PAO PAO CROSS-term dependence of ALPHAO $\rm m^3/V$ 0 PAO PAO CROSS-term dependence of ALPHAO $\rm m^3/V$ 0 PAO PAO CROSS-term dependence of ALPHAOBI $\rm m^2/V$ 0 PAO PAO CROSS-term dependence of ALPHAOBI $\rm m^3/V$ 0 PAO PAO PAO CROSS-term dependence of ALPHAOBI $\rm m^3/V$ 0 PAO PAO CROSS-term dependence of ALPHAOBI $\rm m^3/V$ 0 PAO PAO PAO CROSS-term dependence of ALPHAOBI $\rm m^3/V$ 0 PAO PAO PAO CROSS-term dependence of ALPHAOBI $\rm m^3/V$ 0 PAO   | LXBJT     | Length dependence of XBJT         | m                    | 0                  |
| LXRCRG1 Length dependence of XRCRG1 m 0  LXRCRG2 Length dependence of XRCRG2 m 0  LXREC Length dependence of XREC m 0  LXTUN Length dependence of XTUN m 0  PAO Cross-term dependence of A0 m² 0  PAI Cross-term dependence of A1 m²/V 0  PAZ Cross-term dependence of A2 m² 0  PACDE Cross-term dependence of A2 m² 0  PAGIDL Cross-term dependence of ACDE m³/V 0  PAGIDL Cross-term dependence of AELY Vm 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIS Cross-term dependence of AGS m²/V 0  PAIGC Cross-term dependence of AHLI m² 0  PAIGC Cross-term dependence of AIGC (F/g) <sup>1/2</sup> sm²/ $\Omega$ mV  PAIGSD Cross-term dependence of AIGSD (F/g) <sup>1/2</sup> sm²/ $\Omega$ mV  PALPHAO Cross-term dependence of ALPHAO m³/V 0  PALPHAGB1 Cross-term dependence of ALPHAGB1 m²/V 0  | LXDIF     | Length dependence of XDIF         | m                    | 0                  |
| LXRCRG2 Length dependence of XRCRG2 m 0  LXREC Length dependence of XREC m 0  LXTUN Length dependence of XTUN m 0  PA0 Cross-term dependence of A0 m² 0  PA1 Cross-term dependence of A1 m²/V 0  PA2 Cross-term dependence of A2 m² 0  PACDE Cross-term dependence of ACDE m³/V 0  PAELY Cross-term dependence of AELY Vm 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGS Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAHLI Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAIGC Cross-term dependence of AHLI m² 0  PAIGC Cross-term dependence of AIGC (F/g) <sup>1/2</sup> sm²- $\Omega$ mV  PAIGSD Cross-term dependence of AIGSD (F/g) <sup>1/2</sup> sm²- $\Omega$ mV  PALPHAO Cross-term dependence of ALPHAO m³/V 0  PALPHAGB1 Cross-term dependence of ALPHAOB1 m²/V 0   | LXJ       | Length dependence of XJ           | m <sup>2</sup>       | 0                  |
| LEXREC Length dependence of XREC m 0  LEXTUN Length dependence of XTUN m 0  PAO Cross-term dependence of A0 m² 0  PA1 Cross-term dependence of A1 m²/V 0  PA2 Cross-term dependence of A2 m² 0  PACDE Cross-term dependence of A2 m³/V 0  PAELY Cross-term dependence of ACDE m³/V 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAGIDL Cross-term dependence of AGIDL m²/ $\Omega$ 0  PAHLI Cross-term dependence of AHLI m² 0  PAIGC Cross-term dependence of AHLI m² 0  PAIGC Cross-term dependence of AIGC (F/g) $^{1/2}$ sm²/ $\Omega$ mV  PAIGSD Cross-term dependence of AIGSD (F/g) $^{1/2}$ sm²/ $\Omega$ mV  PALPHAO Cross-term dependence of ALPHAO m³/V 0  PALPHAGB1 Cross-term dependence of ALPHAGB1 m²/V 0   | LXRCRG1   | Length dependence of XRCRG1       | m                    | 0                  |
| LEXTUN Length dependence of XTUN $m = 0$ PAO Cross-term dependence of AO $m^2 = 0$ PAO Cross-term dependence of AI $m^2/V = 0$ PAO Cross-term dependence of AI $m^2/V = 0$ PACDE Cross-term dependence of ACDE $m^3/V = 0$ PACDE Cross-term dependence of ACDE $m^3/V = 0$ PAGIDL Cross-term dependence of AELY $m^2 = 0$ PAGIDL Cross-term dependence of AGIDL $m^2/\Omega = 0$ PAGS Cross-term dependence of AGS $m^2/V = 0$ PAHLI Cross-term dependence of AHLI $m^2 = 0$ PAIGC Cross-term dependence of AIGC $(F/g)^{1/2} sm^2 \ell m V$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2} sm^2 \ell m V$ PALPHAO Cross-term dependence of ALPHAO $m^3/V = 0$ PALPHAGB1 Cross-term dependence of ALPHAOB1 $m^2/V = 0$   | LXRCRG2   | Length dependence of XRCRG2       | m                    | 0                  |
| PAO Cross-term dependence of AO m² 0 PA1 Cross-term dependence of A1 m²/V 0 PA2 Cross-term dependence of A2 m² 0 PACDE Cross-term dependence of ACDE m³/V 0 PAELY Cross-term dependence of AELY Vm 0 PAGIDL Cross-term dependence of AGIDL m²/Q 0 PAGS Cross-term dependence of AGIDL m²/Q 0 PAHLI Cross-term dependence of AHLI m² 0 PAIGC Cross-term dependence of AHLI m² 0 PAIGC Cross-term dependence of AIGC (F/g) $^{1/2}$ sm²/ $^{2}$ mV PAIGSD Cross-term dependence of AIGSD (F/g) $^{1/2}$ sm²/ $^{2}$ mV PALPHAO Cross-term dependence of ALPHAO m³/V 0 PALPHAGB1 Cross-term dependence of ALPHAGB1 m²/V 0   | LXREC     | Length dependence of XREC         | m                    | 0                  |
| Cross-term dependence of A1 $m^2/V$ 0  PACDE Cross-term dependence of A2 $m^2$ 0  PACDE Cross-term dependence of ACDE $m^3/V$ 0  PACDE Cross-term dependence of ACDE $m^3/V$ 0  PAGIDL Cross-term dependence of AGIDL $m^2/\Omega$ 0  PAGS Cross-term dependence of AGS $m^2/V$ 0  PAHLI Cross-term dependence of AHLI $m^2$ 0  PAIGC Cross-term dependence of AIGC $(F/g)^{1/2}sm^2 \theta mV$ PAIGSD Cross-term dependence of AIGSD $m^3/V$ 0  PALPHAO Cross-term dependence of ALPHAO $m^3/V$ 0  PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^3/V$ 0  | LXTUN     | Length dependence of XTUN         | m                    | 0                  |
| Cross-term dependence of A2 $m^2 = 0$ PACDE Cross-term dependence of ACDE $m^3/V = 0$ PACDE Cross-term dependence of ACDE $m^3/V = 0$ PAGIDL Cross-term dependence of AGIDL $m^2/\Omega = 0$ PAGS Cross-term dependence of AGS $m^2/V = 0$ PAHLI Cross-term dependence of AHLI $m^2 = 0$ PAIGC Cross-term dependence of AIGC $(F/g)^{1/2} sm^2 l m V$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2} sm^2 l m V$ PALPHAO Cross-term dependence of ALPHAO $m^3/V = 0$ PALPHAGB1 Cross-term dependence of ALPHAO $m^3/V = 0$   | PA0       | Cross-term dependence of A0       | $m^2$                | 0                  |
| PACDE Cross-term dependence of ACDE $m^3/V = 0$ PAGIDL Cross-term dependence of AGIDL $m^2/\Omega = 0$ PAGS Cross-term dependence of AGS $m^2/V = 0$ PAHLI Cross-term dependence of AHLI $m^2 = 0$ PAIGC Cross-term dependence of AIGC $(F/g)^{1/2}sm^2 MnV$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2}sm^2 MnV$ PALPHAO Cross-term dependence of ALPHAO $m^3/V = 0$ PALPHAGB1 Cross-term dependence of ALPHAO $m^3/V = 0$   | PA1       | Cross-term dependence of A1       | $m^2/V$              | 0                  |
| PAELY Cross-term dependence of AELY Vm 0  PAGIDL Cross-term dependence of AGIDL $m^2/\Omega$ 0  PAGS Cross-term dependence of AGS $m^2/V$ 0  PAHLI Cross-term dependence of AHLI $m^2$ 0  PAIGC Cross-term dependence of AIGC $(F/g)^{1/2} sm^2 \Omega mV$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2} sm^2 \Omega mV$ PALPHA0 Cross-term dependence of ALPHA0 $m^3/V$ 0  PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^2/V$ 0   | PA2       | Cross-term dependence of A2       | $\overline{m^2}$     | 0                  |
| PAGIDL Cross-term dependence of AGIDL $m^2/\Omega$ 0 PAGS Cross-term dependence of AGS $m^2/V$ 0 PAHLI Cross-term dependence of AHLI $m^2$ 0 PAIGC Cross-term dependence of AIGC $(F/g)^{1/2}sm^2\Omega mV$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2}sm^2\Omega mV$ PALPHA0 Cross-term dependence of ALPHA0 $m^3/V$ 0 PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^2/V$ 0   | PACDE     | Cross-term dependence of ACDE     | m <sup>3</sup> /V    | 0                  |
| PAGS Cross-term dependence of AGS $m^2/V$ 0  PAHLI Cross-term dependence of AHLI $m^2$ 0  PAIGC Cross-term dependence of AIGC $(F/g)^{1/2} sm^2 \Omega mV$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2} sm^2 \Omega mV$ PALPHA0 Cross-term dependence of ALPHA0 $m^3/V$ 0  PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^2/V$ 0   | PAELY     | Cross-term dependence of AELY     | Vm                   | 0                  |
| PAHLI Cross-term dependence of AHLI $m^2 = 0$ PAIGC Cross-term dependence of AIGC $(F/g)^{1/2} sm^2 \Omega mV$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2} sm^2 \Omega mV$ PALPHA0 Cross-term dependence of ALPHA0 $m^3/V = 0$ PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^2/V = 0$  | PAGIDL    | Cross-term dependence of AGIDL    | $m^2/\Omega$         | 0                  |
| PAIGC Cross-term dependence of AIGC $(F/g)^{1/2} sm^2 \Omega mV$ PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2} sm^2 \Omega mV$ PALPHA0 Cross-term dependence of ALPHA0 $m^3/V$ 0 PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^2/V$ 0  | PAGS      | Cross-term dependence of AGS      | m <sup>2</sup> /V    | 0                  |
| PAIGSD Cross-term dependence of AIGSD $(F/g)^{1/2}sm^2 \Omega nV$ PALPHAO Cross-term dependence of ALPHAO $m^3/V$ 0 PALPHAGB1 Cross-term dependence of ALPHAGB1 $m^2/V$ 0  | PAHLI     | Cross-term dependence of AHLI     | $m^2$                | 0                  |
| PALPHAO Cross-term dependence of ALPHAO m <sup>3</sup> /V 0 PALPHAGB1 Cross-term dependence of ALPHAGB1 m <sup>2</sup> /V 0  | PAIGC     | Cross-term dependence of AIGC     | $(F/g)^{1/2}s$       | m <sup>2</sup> 0mV |
| PALPHAGB1 Cross-term dependence of ALPHAGB1 m <sup>2</sup> /V 0  | PAIGSD    | Cross-term dependence of AIGSD    | $(F/g)^{1/2}s$       | m <sup>2</sup> 0mV |
| •  | PALPHA0   | Cross-term dependence of ALPHA0   | m <sup>3</sup> /V    | 0                  |
| PALPHAGB2 Cross-term dependence of ALPHAGB2 m <sup>2</sup> /V 0  | PALPHAGB1 | Cross-term dependence of ALPHAGB1 | m <sup>2</sup> /V    | 0                  |
|  | PALPHAGB2 | Cross-term dependence of ALPHAGB2 | m <sup>2</sup> /V    | 0                  |

Table 2-101. BSIM3 SOI Device Model Parameters

| PEBO   Cross-term dependence of B0   m²   0  | Parameter   | Description                      | Units                   | Default             |
|--|-------------|----------------------------------|-------------------------|---------------------|
| Cross-term dependence of B1  | PAT         | Cross-term dependence of AT      | m <sup>3</sup> /s       | 0                   |
| Cross-term dependence of BETAO Vm² 0  PBETA1 Cross-term dependence of BETA1 m² 0  PBETA2 Cross-term dependence of BETA2 Vm² 0  PBETA3 Cross-term dependence of BETA3 m² 0  PBETA3 Cross-term dependence of BIGS (F/g) 1/2 sm² 0 m² 0  PBETA3 Cross-term dependence of BIGS (F/g) 1/2 sm² 0 m² 0  PBETA3 Cross-term dependence of CDSC F 0  PCDSC Cross-term dependence of CGDL Fm 0  PCCGL Cross-term dependence of CGSL Fm 0  PCCGL Cross-term dependence of CGSL Fm 0  PCCGL Cross-term dependence of CGSL Fm 0  PCCGL Cross-term dependence of CIGC Fm² 0  PCCGT Cross-term dependence of CIGC Fm² 0  PCCGT Cross-term dependence of CIGSD F/V 0  PCCGT Cross-term dependence of CIGSD FM² 0  PCCGT Cross-term dependence of DELTA Vm² 0  PCCGT Cross-term depe   | PB0         | Cross-term dependence of B0      | $m^3$                   | 0                   |
| PEETA1 Cross-term dependence of BETA1 m² 0 PEETA2 Cross-term dependence of BETA2 Vm² 0 PEETAGB1 Cross-term dependence of BETAGB1 m²/V² 0 PEETAGB2 Cross-term dependence of BETAGB2 m²/V² 0 PEETAGB2 Cross-term dependence of BETAGB2 m²/V² 0 PEETAGB2 Cross-term dependence of BIGIL Vm 0 PEETAGB2 Cross-term dependence of BIGIL Vm 0 PEETAGB2 Cross-term dependence of BIGIL Vm 0 PEETAGB2 Cross-term dependence of BIGID (F/g)¹/²-sm²/fmV V PEETAGB2 Cross-term dependence of BIGS (F/g)¹/²-sm²/fmV V PEETAGB2 Cross-term dependence of BIGS (F/g)¹/²-sm²/fmV V PEETAGB2 Cross-term dependence of CDSC F 0 PEEDAGC Cross-term dependence of CGDL F  0 PEEDAGC Cross-term dependence of CGDL F  0 PEEDAGC Cross-term dependence of CGDL F  0 PEEDAGC Cross-term dependence of CGDL F  0 PEEDAGC Cross-term dependence of CIGC F  0 PEEDAGC Cross-term dependence of DELVT Vm² 0 PEEDAGC Cross-term dependence of DVT0 M  0 PEEDAGC Cross-term depend   | PB1         | Cross-term dependence of B1      | $m^3$                   | 0                   |
| Cross-term dependence of BETA2 Vm² 0  PBETAGB1 Cross-term dependence of BETAGB1 m²/V² 0  PBETAGB2 Cross-term dependence of BETAGB2 m²/V² 0  PBETAGB2 Cross-term dependence of BETAGB2 m²/V² 0  PBETAGB2 Cross-term dependence of BGIDL Vm 0  PBETAGB2 Cross-term dependence of BIGC (F/g)¹/² sm²/bm V  PBETAGB2 Cross-term dependence of BIGC (F/g)¹/² sm²/bm V  PBETAGB2 Cross-term dependence of BIGSD (F/g)¹/² sm²/bm V  PBETAGB2 Cross-term dependence of CDSC F 0  PBETAGB2 Cross-term dependence of CDSC F 0  PBETAGB2 Cross-term dependence of CDSCB F/V 0  PBETAGB2 Cross-term dependence of CDSCD F/V 0  PBETAGB2 Cross-term dependence of CDSCD F/V 0  PBETAGB2 Cross-term dependence of CGDL Fm 0  PBETAGB2 Cross-term dependence of CGDL Fm 0  PBETAGB3 Cross-term dependence of CGDL Fm 0  PBETAGB4 Cross-term dependence of CIGC Fm²/V 0  PBETAGB4 Cross-term dependence of CIGC Fm²/V 0  PBETAGB4 Cross-term dependence of CIGSD Fm²/V 0  PBETAGB4 Cross-term dependence of CIGAD Fm²/V 0  PBETAGB4 Cross-term dependence of CKAPPA Fm 0  PBETATA Cross-term dependence of DELTA Vm² 0  PBETATA Cross-term dependence of DELTA Vm² 0  PBETATA Cross-term dependence of DELTA Vm² 0  PBETAGB4 Cross-term dependence of DELTA Vm² 0  PBETAGB5 Cross-term dependence of DELTA Vm² 0  PBETAGB6 Cross-term dependence of DELTA Vm² 0   | PBETA0      | Cross-term dependence of BETA0   | Vm <sup>2</sup>         | 0                   |
| PEBETAGB1         Cross-term dependence of BETAGB1         m²/V²         0           PBETAGB2         Cross-term dependence of BETAGB2         m²/V²         0           PBGIDL         Cross-term dependence of BGDL         Vm         0           PBGDC         Cross-term dependence of BIGC         (F/g)¹/²sm²0mV           PBIGGD         Cross-term dependence of BIGSD         (F/g)¹/²sm²0mV           PBIGGD         Cross-term dependence of CDSC         F         0           PCDSCB         Cross-term dependence of CDSCB         F/V         0           PCDSCB         Cross-term dependence of CDSCB         F/V         0           PCGDL         Cross-term dependence of COSCD         F/V         0           PCGDL         Cross-term dependence of CGDL         Fm         0           PCGDL         Cross-term dependence of CGSL         Fm         0           PCGGL         Cross-term dependence of CIGC         m²²V         0           PCGIGG         Cross-term dependence of CIGSD         m²²V         0           PCGIT         Cross-term dependence of CIGSD         m²²V         0           PCGAAPPA         Fm         0         0           PCLATA         Cross-term dependence of DLTA         Vm²         0  | PBETA1      | Cross-term dependence of BETA1   | m <sup>2</sup>          | 0                   |
| Cross-term dependence of BETAGB2 m²/V² 0  PBIGC Cross-term dependence of BGIDL Vm 0  PBIGSD Cross-term dependence of BIGC (F/g)¹/²sm²0mV  PBIGSD Cross-term dependence of BIGSD (F/g)¹/²sm²0mV  PBIGSD Cross-term dependence of BIGSD (F/g)¹/²sm²0mV  PBIGSD Cross-term dependence of CDSC F 0  PCDSC Cross-term dependence of CDSC F 0  PCDSCB Cross-term dependence of CDSCB F/V 0  PCDSCB Cross-term dependence of CDSCB F/V 0  PCDSCB Cross-term dependence of CDSCB F/V 0  PCGBL Cross-term dependence of CGDL Fm 0  PCGGSL Cross-term dependence of CGSL Fm 0  PCGIGC Cross-term dependence of CIGC m²/V 0  PCGIGC Cross-term dependence of CIGSD m²/V 0  PCGIGC Cross-term dependence of CIGSD m²/V 0  PCGIGC Cross-term dependence of CIGSD m²/V 0  PCGAAPPA Cross-term dependence of CIT F 0  PCCAAPPA Cross-term dependence of CIT F 0  PCCAAPPA Cross-term dependence of DELTA Vm² 0  PCDELTA Cross-term dependence of DELTA Vm² 0  PCDDUT Cross-term dependence of DROUT m² 0  PCDDUT Cross-term dependence of DROUT m² 0  PCDDUT Cross-term dependence of DVTO m² 0  PCDVTO Cr   | PBETA2      | Cross-term dependence of BETA2   | Vm <sup>2</sup>         | 0                   |
| PERIOD  Cross-term dependence of BGIDL  Vm 0  PERIOD  Cross-term dependence of BIGC  (F/g) <sup>1/2</sup> sm <sup>2</sup> 0mV  PERIOD  Cross-term dependence of BIGSD  (F/g) <sup>1/2</sup> sm <sup>2</sup> 0mV  PERIOD  Cross-term dependence of CDSC  F 0  PEDDSCB  Cross-term dependence of CDSCB  F/V 0  PEDDSCB  Cross-term dependence of CDSCB  PCODSCB  Cross-term dependence of CDSCB  PCODSCB  PCODSCB  Cross-term dependence of CDSCB  PCODSCB  PCODSCB  Cross-term dependence of CDSCB  PCODSCB  PCODSCB  Cross-term dependence of CGDL  PCODSCB  PCODSCB  Cross-term dependence of CGSL  PCODSCB  PCODSCB  Cross-term dependence of CIGC  PCODSCB  PCODSCB  Cross-term dependence of CIGCB  PCODSCB  PCODSCB  PCODSCB  Cross-term dependence of CIGSD  PCODSCB  P | PBETAGB1    | Cross-term dependence of BETAGB1 | $m^2/V^2$               | 0                   |
| PERICC Cross-term dependence of BIGC $(F/g)^{1/2} sm^2 fm V$ PERIGSD Cross-term dependence of BIGSD $(F/g)^{1/2} sm^2 fm V$ PEDISC Cross-term dependence of CDSC F 0 PEDISCB Cross-term dependence of CDSCB F/V 0 PEDISCB Cross-term dependence of CDSCB F/V 0 PEDISCB Cross-term dependence of CDSCB F/V 0 PEDISCB Cross-term dependence of CDSCD F/V 0 PEDISCB CROSS-term dependence of CGDL Fm 0 PEDISCB CROSS-term dependence of CGDL Fm 0 PEDISCB CROSS-term dependence of CGSL Fm 0 PEDISCB CROSS-term dependence of CIGC M2/V 0 PEDISCB CROSS-term dependence of CIGC M2/V 0 PEDISCB CROSS-term dependence of CIGSD M2/V 0 PEDISCB CROSS-term dependence of CIGSD M2/V 0 PEDISCB CROSS-term dependence of CKAPPA Fm 0 PEDISCB CROSS-term dependence of DELITA Vm2 0 PEDISCB CROSS-term dependence of DELITA Vm2 0 PEDISCB CROSS-term dependence of DELITA Vm2 0 PEDISUB CROSS-term dependence of DSUB M2 0 PEDISUB CROSS-term dependence of DSUB M2 0 PEDIVTO CROSS-term dependence of DVTO M3 0 PE  | PBETAGB2    | Cross-term dependence of BETAGB2 | $m^2/V^2$               | 0                   |
| PERIGSD Cross-term dependence of BIGSD $(F/g)^{1/2} sm^2 / mV$ PCDSC Cross-term dependence of CDSC F 0  PCDSCB Cross-term dependence of CDSCB F/V 0  PCDSCB Cross-term dependence of CDSCB F/V 0  PCDSCD Cross-term dependence of CDSCD F/V 0  PCGGL Cross-term dependence of CGDL Fm 0  PCGGL Cross-term dependence of CGDL Fm 0  PCGGSL Cross-term dependence of CGSL Fm 0  PCIGC Cross-term dependence of CIGC $m^2/V$ 0  PCIGSD Cross-term dependence of CIGC $m^2/V$ 0  PCIGSD Cross-term dependence of CIGSD $m^2/V$ 0  PCIGT Cross-term dependence of CIT F 0  PCKAPPA Cross-term dependence of CKAPPA Fm 0  PCHAPPA Cross-term dependence of DELTA $Vm^2$ 0  PCDELTA Cross-term dependence of DELTA $Vm^2$ 0  PCDELVT Cross-term dependence of DELVT $Vm^2$ 0  PCDSUB Cross-term dependence of DROUT $m^2$ 0  PCDSUB Cross-term dependence of DNOUT $m^2$ 0  PCDVTO Cross-term dependence of DVTO $m^2$ 0  PCDVT1 Cross-term dependence of DVTO $m^2$ 0  PCDVT2 Cross-term dependence of DVT1 $m^2$ 0  PCDVT2 Cross-term dependence of DVT2 $m^2/V$ 0  PCDVT2 Cross-term dependence of DVT2 $m^2/V$ 0  PCDVT2 Cross-term dependence of DVT2 $m^2/V$ 0  PCDWB Cross-term dependence of DWB $m^3/V^{1/2}$ 0  PCDWG Cross-term dependence of DWG $m^3/V^{1/2}$ 0  PCETAO Cross-term dependence of EXATII $Vm$ 0  PCETAO Cross-term dependence of EXATII $Vm$ 0  PCETAO Cross-term dependence of ETAO $m^2$ 0  | PBGIDL      | Cross-term dependence of BGIDL   | Vm                      | 0                   |
| PEDDSC         Cross-term dependence of CDSCB         F         0           PEDSCB         Cross-term dependence of CDSCB         F/V         0           PEDSCD         Cross-term dependence of CDSCD         F/V         0           PEDSCD         Cross-term dependence of CDSCD         F/V         0           PEGGL         Cross-term dependence of CGDL         Fm         0           PECIGC         Cross-term dependence of CIGC         m²/V         0           PECIGSD         Cross-term dependence of CIGSD         m²/V         0           PECIT         Cross-term dependence of CIT         F         0           PECKAPPA         Cross-term dependence of CKAPPA         Fm         0           PEDELTA         Cross-term dependence of DELTA         Vm²         0           PEDELVT         Cross-term dependence of DELVT         Vm²         0           PEDSUB         Cross-term dependence of DROUT         m²         0           PEDSUB         Cross-term dependence of DSUB         m²         0           PEDVTO         Cross-term dependence of DVTO         m²         0           PEDVTO         Cross-term dependence of DVTOW         m         0           PEDVT1         Cross-term dependence of DVT1W         <   | PBIGC       | Cross-term dependence of BIGC    | (F/g) <sup>1/2</sup> sı | m <sup>2</sup> OmV  |
| PCDSCB Cross-term dependence of CDSCB F/V 0 PCDSCD Cross-term dependence of CDSCD F/V 0 PCGSL Cross-term dependence of CGDL Fm 0 PCGSL Cross-term dependence of CGSL Fm 0 PCGGSL Cross-term dependence of CGSL Fm 0 PCGGSL Cross-term dependence of CIGC m²/V 0 PCGGSL Cross-term dependence of CIGC m²/V 0 PCGGSD Cross-term dependence of CIGSD m²/V 0 PCGGSD Cross-term dependence of CIGSD F 0 PCGGSD Cross-term dependence of CIGSD M²/V 0 PCGGSD Cross-term dependence of CIGSD M²/V 0 PCCAPPA Cross-term dependence of CKAPPA Fm 0 PCCAPPA Cross-term dependence of DELTA Vm² 0 PCDELTA Cross-term dependence of DELTA Vm² 0 PCDELTA Cross-term dependence of DROUT M² 0 PCDSUB Cross-term dependence of DROUT M² 0 PCDSUB Cross-term dependence of DSUB M² 0 PCDVTO Cross-term dependence of DVTO M² 0 PCDVTOW Cross-term dependence of DVTO M² 0 PCDVT1 Cross-term dependence of DVT1 M² 0 PCDVT1 Cross-term dependence of DVT1 M² 0 PCDVT1 Cross-term dependence of DVT1 M² 0 PCDVT1 Cross-term dependence of DVT2 M²/V 0 PCDVT2 Cross-term dependence of DVT2 M²/V 0 PCDVT2 Cross-term dependence of DWT M²/V 0 PCDVT2 Cross-term dependence of DWG M³/V1/2 0 PCDWG Cross-term dependence of DWG M³/V1/2 0 PCDWG Cross-term dependence of DWG M³/V1/2 0 PCDWG Cross-term dependence of ESATII Vm 0 PCDWG Cros   | PBIGSD      | Cross-term dependence of BIGSD   | (F/g) <sup>1/2</sup> sı | m <sup>2</sup> .0mV |
| PCDSCD Cross-term dependence of CDSCD F/V 0 PCGDL Cross-term dependence of CGDL Fm 0 PCGSL Cross-term dependence of CGSL Fm 0 PCGGSL Cross-term dependence of CIGC m²/V 0 PCIGC Cross-term dependence of CIGC m²/V 0 PCIGSD Cross-term dependence of CIGSD m²/V 0 PCIT Cross-term dependence of CIGSD F 0 PCKAPPA Cross-term dependence of CKAPPA Fm 0 PCCAPPA Cross-term dependence of DELTA Vm² 0 PCDELTA Cross-term dependence of DELTA Vm² 0 PCDELVT Cross-term dependence of DELVT Vm² 0 PCDROUT Cross-term dependence of DELVT M² 0 PCDSUB Cross-term dependence of DROUT M² 0 PCDVTO Cross-term dependence of DVTO M² 0 PCDVTOW Cross-term dependence of DVTO M² 0 PCDVTOW Cross-term dependence of DVTOW M 0 PCDVT1 Cross-term dependence of DVT1 M² 0 PCDVT1W Cross-term dependence of DVT1W M² 0 PCDVT2W Cross-term dependence of DVT2W M²/V 0 PCDVT2W M²/V 0 PCDVT2W Cross-term dependence of DVT2W M²/V 0 PCDVT2W Cross-term dependence of DVT2W M²/V 0 PCDVT2W M²/V 0 PCDVT2W Cross-term dependence of DVT2W M²/V 0 PCDVT2W Cross-term dependence of DVT2W M²/V 0 PCDVT2W M²/V 0 PCDVT2W Cross-term dependence of DVT2W M²/V 0 PCDVT2W M²/V   | PCDSC       | Cross-term dependence of CDSC    | F                       | 0                   |
| Cross-term dependence of CGDL Fm 0  PCGSL Cross-term dependence of CGSL Fm 0  PCIGC Cross-term dependence of CIGC m²/V 0  PCIGSD Cross-term dependence of CIGSD m²/V 0  PCIT Cross-term dependence of CIGSD m²/V 0  PCIT Cross-term dependence of CIT F 0  PCKAPPA Cross-term dependence of CKAPPA Fm 0  PDELITA Cross-term dependence of DELTA Vm² 0  PDELITA Cross-term dependence of DELTA Vm² 0  PDELITA Cross-term dependence of DELVT Vm² 0  PDEDLYT Cross-term dependence of DEVT m² 0  PDEDLYT Cross-term dependence of DROUT m² 0  PDEDUB Cross-term dependence of DSUB m² 0  PDVTO Cross-term dependence of DVTO m² 0  PDVTOW Cross-term dependence of DVTO m² 0  PDVT1 Cross-term dependence of DVT1 m² 0  PDVT1 Cross-term dependence of DVT1 m² 0  PDVT1 Cross-term dependence of DVT1 m² 0  PDVT2 Cross-term dependence of DVT2 m²/V 0  PDVT2 Cross-term dependence of DVT2 m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDWB Cross-term dependence of DWG m³/V¹/2 0  PDWB Cross-term dependence of DWG m³/V¹/2 0  PDWG Cross-term dependence of DWG m³/V¹/2 0  PDESATII Cross-term dependence of ESATII Vm 0  PDETAO Cross-term dependence of ETAO m² 0  PDETAB Cross-term dependence of ETAO m² 0   | PCDSCB      | Cross-term dependence of CDSCB   | F/V                     | 0                   |
| PCGSL Cross-term dependence of CGSL Fm 0 PCIGC Cross-term dependence of CIGC m²/V 0 PCIGSD Cross-term dependence of CIGSD m²/V 0 PCIT Cross-term dependence of CIGSD m²/V 0 PCIT Cross-term dependence of CIT F 0 PCKAPPA Cross-term dependence of CKAPPA Fm 0 PDELITA Cross-term dependence of DELTA Vm² 0 PDELITA Cross-term dependence of DELTA Vm² 0 PDELIVT Cross-term dependence of DROUT m² 0 PDEDUT Cross-term dependence of DROUT m² 0 PDESUB Cross-term dependence of DVTO m² 0 PDEVTO Cross-term dependence of DVTO m² 0 PDEVTO Cross-term dependence of DVTO m° 0 PDETAO CROSS-term dependence of EXATII Vm 0  | PCDSCD      | Cross-term dependence of CDSCD   | F/V                     | 0                   |
| PCIGC Cross-term dependence of CIGC $m^2/V$ 0 PCIGSD Cross-term dependence of CIGSD $m^2/V$ 0 PCIT Cross-term dependence of CIT $F$ 0 PCKAPPA Cross-term dependence of CKAPPA $Fm$ 0 PDELTA Cross-term dependence of DELTA $Vm^2$ 0 PDELTA Cross-term dependence of DELTA $Vm^2$ 0 PDELVT Cross-term dependence of DELVT $Vm^2$ 0 PDEDUT Cross-term dependence of DROUT $m^2$ 0 PDSUB Cross-term dependence of DNOUT $m^2$ 0 PDVT0 Cross-term dependence of DVT0 $m^2$ 0 PDVT0 Cross-term dependence of DVT0 $m^2$ 0 PDVT1 Cross-term dependence of DVT0 $m^2$ 0 PDVT1 Cross-term dependence of DVT1 $m^2$ 0 PDVT2 Cross-term dependence of DVT2 $m^2/V$ 0 PDVT2 Cross-term dependence of DVT2 $m^2/V$ 0 PDVT2 Cross-term dependence of DWT2 $m^2/V$ 0 PDVT2W Cross-term dependence of DWT0 $m^3/V^{1/2}$ 0 PDWG Cross-term dependence of DWG $m^3/V^{1/2}$ 0 PDWG Cross-term dependence of DWG $m^3/V^{1/2}$ 0 PDWG Cross-term dependence of ESATII $m^2$ 0  | PCGDL       | Cross-term dependence of CGDL    | Fm                      | 0                   |
| Cross-term dependence of CIGSD m²/V 0 PCIT Cross-term dependence of CIT F 0 PCKAPPA Cross-term dependence of CKAPPA Fm 0 PDELTA Cross-term dependence of DELTA Vm² 0 PDELTA Cross-term dependence of DELTA Vm² 0 PDELVT Cross-term dependence of DELVT Vm² 0 PDEDUT Cross-term dependence of DROUT m² 0 PDEDUT Cross-term dependence of DSUB m² 0 PDVT0 Cross-term dependence of DVT0 m² 0 PDVT0W Cross-term dependence of DVT0W m 0 PDVT1W Cross-term dependence of DVT1W m² 0 PDVT1W Cross-term dependence of DVT1W m 0 PDVT1W Cross-term dependence of DVT1W m 0 PDVT2 Cross-term dependence of DVT2 m²/V 0 PDVT2W Cross-term dependence of DVT2W m²/V 0 PDVT2W Cross-term dependence of DVT2W m²/V 0 PDVT2W Cross-term dependence of DWB m³/V¹/2 0 PDWG Cross-term dependence of DWG m³/V¹/2 0 PDWG Cross-term dependence of DWG m³/V¹/2 0 PDWG Cross-term dependence of ESATII Vm 0 PDETAB Cross-term dependence of ETAO m² 0 PDETAB Cross-term dependence of ETAO m²/V 0   | PCGSL       | Cross-term dependence of CGSL    | Fm                      | 0                   |
| PCIT Cross-term dependence of CIT F 0 PCKAPPA Cross-term dependence of CKAPPA Fm 0 PDELITA Cross-term dependence of DELTA Vm² 0 PDELITA Cross-term dependence of DELVT Vm² 0 PDELVT Cross-term dependence of DELVT $Vm^2$ 0 PDEOUT Cross-term dependence of DROUT $m^2$ 0 PDEOUT Cross-term dependence of DROUT $m^2$ 0 PDEOUTO Cross-term dependence of DVTO $m^2$ 0 PDEOUTO Cross-term dependence of DWG $m^3/V^{1/2}$ 0 PDEOUTO Cross-term dependence of ESATII $m^2$ 0 PDEOUTO CROSS-term dependence of ESATII $m^2$ 0 PDEOUTO CROSS-term dependence of ETAO $m^2$ 0 PDEOUTO CROSS-term dependence of ETAO $m^2$ 0 PDEOUTO CROSS-term dependence of ETAO $m^2$ 0   | PCIGC       | Cross-term dependence of CIGC    | m <sup>2</sup> /V       | 0                   |
| PCKAPPA Cross-term dependence of CKAPPA Fm 0  PDELITA Cross-term dependence of DELTA Vm² 0  PDELVT Cross-term dependence of DELVT Vm² 0  PDROUT Cross-term dependence of DROUT m² 0  PDSUB Cross-term dependence of DSUB m² 0  PDVT0 Cross-term dependence of DVT0 m² 0  PDVT0W Cross-term dependence of DVT0W m 0  PDVT1 Cross-term dependence of DVT1 m² 0  PDVT1W Cross-term dependence of DVT1W m 0  PDVT2 Cross-term dependence of DVT2 m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDVT2W Cross-term dependence of DWB m³/V¹/2 0  PDWB Cross-term dependence of DWG m³/V¹/2 0  PDWG Cross-term dependence of DWG m³/V¹/2 0  PDWG Cross-term dependence of ESATII Vm 0  PDETAD Cross-term dependence of ETAD m²/V 0   | PCIGSD      | Cross-term dependence of CIGSD   | m <sup>2</sup> /V       | 0                   |
| PDELITA Cross-term dependence of DELTA Vm² 0  PDELVT Cross-term dependence of DELVT Vm² 0  PDELVT Cross-term dependence of DELVT Vm² 0  PDEDUT Cross-term dependence of DROUT m² 0  PDSUB Cross-term dependence of DSUB m² 0  PDVT0 Cross-term dependence of DVT0 m² 0  PDVT0W Cross-term dependence of DVT0W m 0  PDVT1 Cross-term dependence of DVT1 m² 0  PDVT1W Cross-term dependence of DVT1W m 0  PDVT2 Cross-term dependence of DVT2 m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDWB Cross-term dependence of DWB m³/V¹/2 0  PDWG Cross-term dependence of DWG m³/V¹/2 0  PDWG Cross-term dependence of ESATII Vm 0  PDETAD Cross-term dependence of ETAD m²/V 0   | PCIT        | Cross-term dependence of CIT     | F                       | 0                   |
| PDELVT         Cross-term dependence of DELVT         Vm²         0           PDROUT         Cross-term dependence of DROUT         m²         0           PDSUB         Cross-term dependence of DSUB         m²         0           PDVT0         Cross-term dependence of DVT0         m²         0           PDVT0W         Cross-term dependence of DVT0W         m         0           PDVT1         Cross-term dependence of DVT1         m²         0           PDVT1W         Cross-term dependence of DVT1W         m         0           PDVT2         Cross-term dependence of DVT2         m²/V         0           PDVT2W         Cross-term dependence of DVT2W         m²/V         0           PDWB         Cross-term dependence of DWG         m³/V¹/²         0           PDWG         Cross-term dependence of ESATII         Vm         0           PETAD         Cross-term dependence of ETAO         m²         0           PETAB         Cross-term dependence of ETAB         m²/V         0  | PCKAPPA     | Cross-term dependence of CKAPPA  | Fm                      | 0                   |
| PDROUT Cross-term dependence of DROUT $m^2 = 0$ PDSUB Cross-term dependence of DSUB $m^2 = 0$ PDVT0 Cross-term dependence of DVT0 $m^2 = 0$ PDVT0W Cross-term dependence of DVT0W $m = 0$ PDVT1 Cross-term dependence of DVT1 $m^2 = 0$ PDVT1W Cross-term dependence of DVT1W $m = 0$ PDVT2W Cross-term dependence of DVT2W $m^2/V = 0$ PDVT2W Cross-term dependence of DVT2W $m^2/V = 0$ PDVT2W Cross-term dependence of DWB $m^3/V^{1/2} = 0$ PDWB Cross-term dependence of DWG $m^3/V^{1/2} = 0$ PDWG Cross-term dependence of ESATII $v = 0$ PESATII Cross-term dependence of ESATII $v = 0$ PETAD Cross-term dependence of ETAD $m^2 = 0$ PDETAB Cross-term dependence of ETAB $m^2/V = 0$  | PDELTA      | Cross-term dependence of DELTA   | Vm <sup>2</sup>         | 0                   |
| PDSUB Cross-term dependence of DSUB $m^2 = 0$ PDVT0 Cross-term dependence of DVT0 $m^2 = 0$ PDVT0W Cross-term dependence of DVT0W $m = 0$ PDVT1 Cross-term dependence of DVT1 $m^2 = 0$ PDVT1W Cross-term dependence of DVT1W $m = 0$ PDVT2 Cross-term dependence of DVT2 $m^2/V = 0$ PDVT2W Cross-term dependence of DVT2W $m^2/V = 0$ PDVT2W Cross-term dependence of DVT2W $m^2/V = 0$ PDWB Cross-term dependence of DWB $m^3/V^{1/2} = 0$ PDWG Cross-term dependence of DWG $m^3/V^{1/2} = 0$ PDWG Cross-term dependence of ESATII $m^2 = 0$ PDESATII Cross-term dependence of ETAO $m^2 = 0$ PDETAD Cross-term dependence of ETAB $m^2/V = 0$   | PDELVT      | Cross-term dependence of DELVT   | Vm <sup>2</sup>         | 0                   |
| PDVT0 Cross-term dependence of DVT0 m² 0  PDVT1W Cross-term dependence of DVT1 m² 0  PDVT1W Cross-term dependence of DVT1W m 0  PDVT2 Cross-term dependence of DVT2 m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDWB Cross-term dependence of DWB m³/V $^{1/2}$ 0  PDWG Cross-term dependence of DWG m³/V $^{1/2}$ 0  PESATII Cross-term dependence of ESATII Vm 0  PETAO Cross-term dependence of ETAO m² 0  PETAB Cross-term dependence of ETAB m²/V 0   | PDROUT      | Cross-term dependence of DROUT   | $m^2$                   | 0                   |
| Cross-term dependence of DVT0W m 0  PDVT1 Cross-term dependence of DVT1 m <sup>2</sup> 0  PDVT1W Cross-term dependence of DVT1W m 0  PDVT2 Cross-term dependence of DVT2 m <sup>2</sup> /V 0  PDVT2W Cross-term dependence of DVT2W m <sup>2</sup> /V 0  PDWB Cross-term dependence of DWB m <sup>3</sup> /V <sup>1/2</sup> 0  PDWG Cross-term dependence of DWG m <sup>3</sup> /V <sup>1/2</sup> 0  PESATII Cross-term dependence of ESATII Vm 0  PETAO Cross-term dependence of ETAO m <sup>2</sup> 0  PETAB Cross-term dependence of ETAB m <sup>2</sup> /V 0   | PDSUB       | Cross-term dependence of DSUB    | m <sup>2</sup>          | 0                   |
| PDVT1 Cross-term dependence of DVT1 m² 0  PDVT1W Cross-term dependence of DVT1W m 0  PDVT2 Cross-term dependence of DVT2 m²/V 0  PDVT2W Cross-term dependence of DVT2W m²/V 0  PDWB Cross-term dependence of DWB m³/V $^{1/2}$ 0  PDWG Cross-term dependence of DWG m³/V $^{1/2}$ 0  PESATII Cross-term dependence of ESATII Vm 0  PETA0 Cross-term dependence of ETA0 m² 0  PETAB Cross-term dependence of ETA0 m² 0  | PDVT0       | Cross-term dependence of DVT0    | $m^2$                   | 0                   |
| PDVT1W Cross-term dependence of DVT1W m 0  PDVT2 Cross-term dependence of DVT2 m $^2$ /V 0  PDVT2W Cross-term dependence of DVT2W m $^2$ /V 0  PDWB Cross-term dependence of DWB m $^3$ /V $^{1/2}$ 0  PDWG Cross-term dependence of DWG m $^3$ /V $^{1/2}$ 0  PESATII Cross-term dependence of ESATII Vm 0  PETA0 Cross-term dependence of ETA0 m $^2$ 0  PETAB Cross-term dependence of ETAB m $^2$ /V 0   | PDVT0W      | Cross-term dependence of DVT0W   | m                       | 0                   |
| PDVT2 Cross-term dependence of DVT2 $m^2/V$ 0  PDVT2W Cross-term dependence of DVT2W $m^2/V$ 0  PDWB Cross-term dependence of DWB $m^3/V^{1/2}$ 0  PDWG Cross-term dependence of DWG $m^3/V^{1/2}$ 0  PESATII Cross-term dependence of ESATII $Vm$ 0  PETA0 Cross-term dependence of ETA0 $m^2$ 0  PETAB Cross-term dependence of ETAB $m^2/V$ 0   | PDVT1       | Cross-term dependence of DVT1    | $m^2$                   | 0                   |
| PDVT2W Cross-term dependence of DVT2W $m^2/V$ 0  PDWB Cross-term dependence of DWB $m^3/V^{1/2}$ 0  PDWG Cross-term dependence of DWG $m^3/V^{1/2}$ 0  PESATII Cross-term dependence of ESATII $Vm$ 0  PETA0 Cross-term dependence of ETA0 $m^2$ 0  PETAB Cross-term dependence of ETAB $m^2/V$ 0  | PDVT1W      | Cross-term dependence of DVT1W   | m                       | 0                   |
| PDWB Cross-term dependence of DWB $m^3/V^{1/2} = 0$ PDWG Cross-term dependence of DWG $m^3/V^{1/2} = 0$ PESATII Cross-term dependence of ESATII $Vm = 0$ PETA0 Cross-term dependence of ETA0 $m^2 = 0$ PETAB Cross-term dependence of ETAB $m^2/V = 0$   | PDVT2       | Cross-term dependence of DVT2    | m <sup>2</sup> /V       | 0                   |
| PDWG Cross-term dependence of DWG $m^3/V^{1/2}$ 0  PESATII Cross-term dependence of ESATII $Vm$ 0  PETA0 Cross-term dependence of ETA0 $m^2$ 0  PETAB Cross-term dependence of ETAB $m^2/V$ 0  | PDVT2W      | Cross-term dependence of DVT2W   | m <sup>2</sup> /V       | 0                   |
| PESATII Cross-term dependence of ESATII Vm 0  PETA0 Cross-term dependence of ETA0 m <sup>2</sup> 0  PETAB Cross-term dependence of ETAB m <sup>2</sup> /V 0  | PDWB        | Cross-term dependence of DWB     | $m^3/V^{1/2}$           | 0                   |
| PETAO Cross-term dependence of ETAO $m^2 = 0$ PETAB Cross-term dependence of ETAB $m^2/V = 0$  | PDWG        | Cross-term dependence of DWG     | $m^3/V^{1/2}$           | 0                   |
| PETAB Cross-term dependence of ETAB m <sup>2</sup> /V 0  | PESATII     | Cross-term dependence of ESATII  | Vm                      | 0                   |
| ı  | PETA0       | Cross-term dependence of ETA0    | $m^2$                   | 0                   |
| <del>-</del>   | PETAB       | Cross-term dependence of ETAB    | m <sup>2</sup> /V       | 0                   |
|  | <br>PFBJTII | Cross-term dependence of FBJTII  | $m^2$                   | 0                   |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                      | Units                           | Default |
|-----------|----------------------------------|---------------------------------|---------|
| PISBJT    | Cross-term dependence of ISBJT   | A                               | 0       |
| PISDIF    | Cross-term dependence of ISDIF   | A                               | 0       |
| PISREC    | Cross-term dependence of ISREC   | A                               | 0       |
| PISTUN    | Cross-term dependence of ISTUN   | A                               | 0       |
| PK1       | Cross-term dependence of K1      | $V^{1/2}m^2$                    | 0       |
| PK1W1     | Cross-term dependence of K1W1    | m <sup>3</sup>                  | 0       |
| PK1W2     | Cross-term dependence of K1W2    | m <sup>3</sup>                  | 0       |
| PK2       | Cross-term dependence of K2      | m <sup>2</sup>                  | 0       |
| PK3       | Cross-term dependence of K3      | m <sup>2</sup>                  | 0       |
| PK3B      | Cross-term dependence of K3B     | m <sup>2</sup> /V               | 0       |
| PKB1      | Cross-term dependence of KB1     | m <sup>2</sup>                  | 0       |
| PKETA     | Cross-term dependence of KETA    | m <sup>2</sup> /V               | 0       |
| PKETAS    | Cross-term dependence of KETAS   | Vm <sup>2</sup>                 | 0       |
| PKT1      | Cross-term dependence of KT1     | Vm <sup>2</sup>                 | 0       |
| PKT1L     | Cross-term dependence of KT1L    | Vm <sup>3</sup>                 | 0       |
| PKT2      | Cross-term dependence of KT2     | m <sup>2</sup>                  | 0       |
| PLBJT0    | Cross-term dependence of LBJT0   | $m^3$                           | 0       |
| PLII      | Cross-term dependence of LII     | m <sup>2</sup>                  | 0       |
| PMOIN     | Cross-term dependence of MOIN    | $m^2$                           | 0       |
| PNBJT     | Cross-term dependence of NBJT    | m <sup>2</sup>                  | 0       |
| PNCH      | Cross-term dependence of NCH     | m <sup>2</sup> /cm <sup>3</sup> | 0       |
| PNDIF     | Cross-term dependence of NDIF    | m <sup>2</sup>                  | 0       |
| PNDIODE   | Cross-term dependence of NDIODE  | $m^2$                           | 0       |
| PNFACTOR  | Cross-term dependence of NFACTOR | m <sup>2</sup>                  | 0       |
| PNGATE    | Cross-term dependence of NGATE   | m <sup>2</sup> /cm <sup>3</sup> | 0       |
| PNGIDL    | Cross-term dependence of NGIDL   | Vm <sup>2</sup>                 | 0       |
| PNIGC     | Cross-term dependence of NIGC    | m <sup>2</sup>                  | 0       |
| PNLX      | Cross-term dependence of NLX     | $m^3$                           | 0       |
| PNOFF     | Cross-term dependence of NOFF    | $m^2$                           | 0       |
| PNRECF0   | Cross-term dependence of NRECF0  | $m^2$                           | 0       |
| PNRECR0   | Cross-term dependence of NRECR0  | $m^2$                           | 0       |
| PNSUB     | Cross-term dependence of NSUB    | m <sup>2</sup> /cm <sup>3</sup> | 0       |
| PNTRECF   | Cross-term dependence of NTRECF  | m <sup>2</sup>                  | 0       |
| PNTRECR   | Cross-term dependence of NTRECR  | $m^2$                           | 0       |
| PNTUN     | Cross-term dependence of NTUN    | $m^2$                           | 0       |
| PPCLM     | Cross-term dependence of PCLM    | $m^2$                           | 0       |
|           | ^                                |                                 |         |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                       | Units                                     | Default          |
|-----------|-----------------------------------|---|------------------|
| PPDIBLC1  | Cross-term dependence of PDIBLC1  | $m^2$                                     | 0                |
| PPDIBLC2  | Cross-term dependence of PDIBLC2  | m <sup>2</sup>                            | 0                |
| PPDIBLCB  | Cross-term dependence of PDIBLCB  | m <sup>2</sup> /V                         | 0                |
| PPIGCD    | Cross-term dependence of PIGCD    | m <sup>2</sup>                            | 0                |
| PPOXEDGE  | Cross-term dependence of POXEDGE  | $m^2$                                     | 0                |
| PPRT      | Cross-term dependence of PRT      | $\frac{\Omega  \mu \text{m}}{\text{m}^2}$ | 0                |
| PPRWB     | Cross-term dependence of PRWB     | $m^2/V^{1/2}$                             | 0                |
| PPRWG     | Cross-term dependence of PRWG     | m <sup>2</sup> /V                         | 0                |
| PPVAG     | Cross-term dependence of PVAG     | $m^2$                                     | 0                |
| PRDSW     | Cross-term dependence of RDSW     | $\Omega \mu m$ $m^2$                      | 0                |
| PSII0     | Cross-term dependence of SII0     | m <sup>2</sup> /V                         | 0                |
| PSII1     | Cross-term dependence of SII1     | m <sup>2</sup> /V                         | 0                |
| PSII2     | Cross-term dependence of SII2     | $m^2$                                     | 0                |
| PSIID     | Cross-term dependence of SIID     | m <sup>2</sup> /V                         | 0                |
| PU0       | Cross-term dependence of U0       | m <sup>2</sup> /(Vcm                      | <sup>2</sup> s)0 |
| PUA       | Cross-term dependence of UA       | m <sup>3</sup> /V                         | 0                |
| PUA1      | Cross-term dependence of UA1      | m <sup>3</sup> /V                         | 0                |
| PUB       | Cross-term dependence of UB       | $m^4/V^2$                                 | 0                |
| PUB1      | Cross-term dependence of UB1      | $m^4/V^2$                                 | 0                |
| PUC       | Cross-term dependence of UC       | $m^3/V^2$                                 | 0                |
| PUC1      | Cross-term dependence of UC1      | m <sup>3</sup> /(°CV <sup>2</sup>         | <sup>2</sup> ) 0 |
| PUTE      | Cross-term dependence of UTE      | $m^2$                                     | 0                |
| PVABJT    | Cross-term dependence of VABJT    | Vm <sup>2</sup>                           | 0                |
| PVDSATII0 | Cross-term dependence of VDSATII0 | Vm <sup>2</sup>                           | 0                |
| PVOFF     | Cross-term dependence of VOFF     | Vm <sup>2</sup>                           | 0                |
| PVREC0    | Cross-term dependence of VREC0    | Vm <sup>2</sup>                           | 0                |
| PVSAT     | Cross-term dependence of VSAT     | m <sup>3</sup> /s                         | 0                |
| PVSDFB    | Cross-term dependence of VSDFB    | Vm <sup>2</sup>                           | 0                |
| PVSDTH    | Cross-term dependence of VSDTH    | Vm <sup>2</sup>                           | 0                |
| PVTH0     | Cross-term dependence of VTH0     | Vm <sup>2</sup>                           | 0                |
| PVTUN0    | Cross-term dependence of VTUN0    | Vm <sup>2</sup>                           | 0                |
| PW0       | Cross-term dependence of W0       | $m^3$                                     | 0                |
| PWR       | Cross-term dependence of WR       | $m^2$                                     | 0                |
| PXBJT     | Cross-term dependence of XBJT     | $m^2$                                     | 0                |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                     | Units             | Default |
|-----------|---------------------------------|-------------------|---------|
| PXDIF     | Cross-term dependence of XDIF   | $m^2$             | 0       |
| PXJ       | Cross-term dependence of XJ     | $m^3$             | 0       |
| PXRCRG1   | Cross-term dependence of XRCRG1 | $m^2$             | 0       |
| PXRCRG2   | Cross-term dependence of XRCRG2 | $m^2$             | 0       |
| PXREC     | Cross-term dependence of XREC   | $m^2$             | 0       |
| PXTUN     | Cross-term dependence of XTUN   | $m^2$             | 0       |
| WA0       | Width dependence of A0          | m                 | 0       |
| WA1       | Width dependence of A1          | m/V               | 0       |
| WA2       | Width dependence of A2          | m                 | 0       |
| WACDE     | Width dependence of ACDE        | m <sup>2</sup> /V | 0       |
| WAELY     | Width dependence of AELY        | V                 | 0       |
| WAGIDL    | Width dependence of AGIDL       | m/Ω               | 0       |
| WAGS      | Width dependence of AGS         | m/V               | 0       |
| WAHLI     | Width dependence of AHLI        | m                 | 0       |
| WAIGC     | Width dependence of AIGC        | $(F/g)^{1/2}s$    | m/maV   |
| WAIGSD    | Width dependence of AIGSD       | $(F/g)^{1/2}s$    | m/maV   |
| VALPHA0   | Width dependence of ALPHA0      | m <sup>2</sup> /V | 0       |
| WALPHAGB1 | Width dependence of ALPHAGB1    | m/V               | 0       |
| WALPHAGB2 | Width dependence of ALPHAGB2    | m/V               | 0       |
| VAT       | Width dependence of AT          | m <sup>2</sup> /s | 0       |
| VB0       | Width dependence of B0          | $m^2$             | 0       |
| VB1       | Width dependence of B1          | $m^2$             | 0       |
| VBETA0    | Width dependence of BETA0       | Vm                | 0       |
| VBETA1    | Width dependence of BETA1       | m                 | 0       |
| VBETA2    | Width dependence of BETA2       | Vm                | 0       |
| WBETAGB1  | Width dependence of BETAGB1     | m/V <sup>2</sup>  | 0       |
| WBETAGB2  | Width dependence of BETAGB2     | m/V <sup>2</sup>  | 0       |
| WBGIDL    | Width dependence of BGIDL       | V                 | 0       |
| WBIGC     | Width dependence of BIGC        | $(F/g)^{1/2}s$    | m/maV   |
| WBIGSD    | Width dependence of BIGSD       | $(F/g)^{1/2}s$    | m/m0V   |
| NCDSC     | Width dependence of CDSC        | F/m               | 0       |
| WCDSCB    | Width dependence of CDSCB       | F/(Vm)            | 0       |
| WCDSCD    | Width dependence of CDSCD       | F/(Vm)            | 0       |
| WCGDL     | Width dependence of CGDL        | F                 | 0       |
| VCGSL     | Width dependence of CGSL        | F                 | 0       |
|           |                                 |                   |         |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                | Units           | Default |
|-----------|----------------------------|-----------------|---------|
| WCIGSD    | Width dependence of CIGSD  | m/V             | 0       |
| WCIT      | Width dependence of CIT    | F/m             | 0       |
| WCKAPPA   | Width dependence of CKAPPA | F               | 0       |
| WDELTA    | Width dependence of DELTA  | Vm              | 0       |
| WDELVT    | Width dependence of DELVT  | Vm              | 0       |
| WDROUT    | Width dependence of DROUT  | m               | 0       |
| WDSUB     | Width dependence of DSUB   | m               | 0       |
| WDVT0     | Width dependence of DVT0   | m               | 0       |
| WDVT0W    | Width dependence of DVT0W  | _               | 0       |
| WDVT1     | Width dependence of DVT1   | m               | 0       |
| WDVT1W    | Width dependence of DVT1W  | _               | 0       |
| WDVT2     | Width dependence of DVT2   | m/V             | 0       |
| WDVT2W    | Width dependence of DVT2W  | m/V             | 0       |
| WDWB      | Width dependence of DWB    | $m^2/V^{1/2}$   | 0       |
| WDWG      | Width dependence of DWG    | $m^2/V^{1/2}$   | 0       |
| WESATII   | Width dependence of ESATII | V               | 0       |
| WETA0     | Width dependence of ETA0   | m               | 0       |
| WETAB     | Width dependence of ETAB   | m/V             | 0       |
| VFBJTII   | Width dependence of FBJTII | m               | 0       |
| WISBJT    | Width dependence of ISBJT  | A/m             | 0       |
| WISDIF    | Width dependence of ISDIF  | A/m             | 0       |
| WISREC    | Width dependence of ISREC  | A/m             | 0       |
| VISTUN    | Width dependence of ISTUN  | A/m             | 0       |
| vK1       | Width dependence of K1     | $V^{1/2}$ m     | 0       |
| WK1W1     | Width dependence of K1W1   | $m^2$           | 0       |
| WK1W2     | Width dependence of K1W2   | $m^2$           | 0       |
| WK2       | Width dependence of K2     | m               | 0       |
| VK3       | Width dependence of K3     | m               | 0       |
| WK3B      | Width dependence of K3B    | m/V             | 0       |
| WKB1      | Width dependence of KB1    | m               | 0       |
| WKETA     | Width dependence of KETA   | m/V             | 0       |
| VKETAS    | Width dependence of KETAS  | Vm              | 0       |
| WKT1      | Width dependence of KT1    | Vm              | 0       |
| WKT1L     | Width dependence of KT1L   | Vm <sup>2</sup> | 0       |
| WKT2      | Width dependence of KT2    | m               | 0       |
| WLBJT0    | Width dependence of LBJT0  | $m^2$           | 0       |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                 | Units                 | Default |
|-----------|-----------------------------|-----------------------|---------|
| WLII      | Width dependence of LII     | m                     | 0       |
| WMOIN     | Width dependence of MOIN    | m                     | 0       |
| WNBJT     | Width dependence of NBJT    | m                     | 0       |
| WNCH      | Width dependence of NCH     | m/cm <sup>3</sup>     | 0       |
| WNDIF     | Width dependence of NDIF    | m                     | 0       |
| WNDIODE   | Width dependence of NDIODE  | m                     | 0       |
| WNFACTOR  | Width dependence of NFACTOR | m                     | 0       |
| WNGATE    | Width dependence of NGATE   | m/cm <sup>3</sup>     | 0       |
| WNGIDL    | Width dependence of NGIDL   | Vm                    | 0       |
| WNIGC     | Width dependence of NIGC    | m                     | 0       |
| WNLX      | Width dependence of NLX     | $m^2$                 | 0       |
| WNOFF     | Width dependence of NOFF    | m                     | 0       |
| WNRECF0   | Width dependence of NRECF0  | m                     | 0       |
| WNRECRO   | Width dependence of NRECR0  | m                     | 0       |
| WNSUB     | Width dependence of NSUB    | m/cm <sup>3</sup>     | 0       |
| WNTRECF   | Width dependence of NTRECF  | m                     | 0       |
| WNTRECR   | Width dependence of NTRECR  | m                     | 0       |
| WNTUN     | Width dependence of NTUN    | m                     | 0       |
| WPCLM     | Width dependence of PCLM    | m                     | 0       |
| WPDIBLC1  | Width dependence of PDIBLC1 | m                     | 0       |
| WPDIBLC2  | Width dependence of PDIBLC2 | m                     | 0       |
| WPDIBLCB  | Width dependence of PDIBLCB | m/V                   | 0       |
| NPIGCD    | Width dependence of PIGCD   | m                     | 0       |
| WPOXEDGE  | Width dependence of POXEDGE | m                     | 0       |
| WPRT      | Width dependence of PRT     | $\Omega \mu$ m m      | 0       |
| WPRWB     | Width dependence of PRWB    | m/V <sup>1/2</sup>    | 0       |
| WPRWG     | Width dependence of PRWG    | m/V                   | 0       |
| WPVAG     | Width dependence of PVAG    | m                     | 0       |
| WRDSW     | Width dependence of RDSW    | $\Omega \mu$ m m      | 0       |
| WSIIO     | Width dependence of SII0    | m/V                   | 0       |
| WSII1     | Width dependence of SII1    | m/V                   | 0       |
| WSII2     | Width dependence of SII2    | m                     | 0       |
| WSIID     | Width dependence of SIID    | m/V                   | 0       |
| WU0       | Width dependence of U0      | m/(Vcm <sup>2</sup> s | ) 0     |
| WUA       | Width dependence of UA      | m <sup>2</sup> /V     | 0       |
|           | Width dependence of UA1     | m <sup>2</sup> /V     |         |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description                          | Units                | Default          |
|-----------|--------------------------------------|----------------------|------------------|
| WUB       | Width dependence of UB               | $m^3/V^2$            | 0                |
| WUB1      | Width dependence of UB1              | $m^3/V^2$            | 0                |
| WUC       | Width dependence of UC               | $m^2/V^2$            | 0                |
| WUC1      | Width dependence of UC1              | m <sup>2</sup> /(°CV | <sup>2</sup> ) 0 |
| WUTE      | Width dependence of UTE              | m                    | 0                |
| WVABJT    | Width dependence of VABJT            | Vm                   | 0                |
| WVDSATII0 | Width dependence of VDSATII0         | Vm                   | 0                |
| WVOFF     | Width dependence of VOFF             | Vm                   | 0                |
| WVREC0    | Width dependence of VREC0            | Vm                   | 0                |
| WVSAT     | Width dependence of VSAT             | m <sup>2</sup> /s    | 0                |
| WVSDFB    | Width dependence of VSDFB            | Vm                   | 0                |
| WVSDTH    | Width dependence of VSDTH            | Vm                   | 0                |
| WVTH0     | Width dependence of VTH0             | Vm                   | 0                |
| WVTUN0    | Width dependence of VTUN0            | Vm                   | 0                |
| WW0       | Width dependence of W0               | $m^2$                | 0                |
| WWR       | Width dependence of WR               | m                    | 0                |
| WXBJT     | Width dependence of XBJT             | m                    | 0                |
| WXDIF     | Width dependence of XDIF             | m                    | 0                |
| WXJ       | Width dependence of XJ               | $m^2$                | 0                |
| WXRCRG1   | Width dependence of XRCRG1           | m                    | 0                |
| WXRCRG2   | Width dependence of XRCRG2           | m                    | 0                |
| WXREC     | Width dependence of XREC             | m                    | 0                |
| WXTUN     | Width dependence of XTUN             | m                    | 0                |
|           | Doping Parameters                    |                      |                  |
| NSUB      | Substrate doping density             | $\mathrm{cm}^{-3}$   | 6e+16            |
|           | Flicker and Thermal Noise Parameters |                      |                  |
| AF        | Flicker noise exponent               | _                    | 1                |
| EF        | Flicker exponent                     | _                    | 1                |
| EM        | Saturation field                     | $Vm^{-1}$            | 4.1e+07          |
| KF        | Flicker noise coefficient            | _                    | 0                |
| NOIA      | Noise parameter a                    | _                    | 0                |
| NOIB      | Noise parameter b                    | _                    | 0                |
| NOIC      | Noise parameter c                    | _                    | 8.75e+09         |
|           | Geometry Parameters                  |                      |                  |
| <br>L     | Channel length                       | m                    | 5e-06            |
| <b>-</b>  | Chambi foligati                      | 111                  | 2000             |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description   | Units                  | Default        |
|-----------|---|------------------------|----------------|
| LL        | Coefficient of length dependence for length offset                      | $m^{LLN}$              | 0              |
| LLC       | Coefficient of length dependence for CV channel length offset           | m <sup>LLN</sup>       | 0              |
| LLN       | Power of length dependence for length offset                            | -                      | 1              |
| LW        | Coefficient of width dependence for length offset                       | m <sup>LWN</sup>       | 0              |
| LWC       | Coefficient of width dependence for channel length offset               | m <sup>LWN</sup>       | 0              |
| LWL       | Coefficient of length and width cross term for length offset            | m <sup>LLN+LWN</sup>   | 0              |
| LWLC      | Coefficient of length and width dependence for CV channel length offset | m <sup>LLN+LWN</sup>   | 0              |
| LWN       | Power of width dependence for length offset                             | _                      | 1              |
| TOX       | Gate oxide thickness  | m                      | 1e-08          |
| W         | Channel width   | m                      | 5e-06          |
| WL        | Coefficient of length dependence for width offset                       | $m^{WLN}$              | 0              |
| WLC       | Coefficient of length dependence for CV channel width offset            | m <sup>WLN</sup>       | 0              |
| WLN       | Power of length dependece of width offset                               | _                      | 1              |
| WW        | Coefficient of width dependence for width offset                        | m <sup>WWN</sup>       | 0              |
| WWC       | Coefficient of width dependence for CV channel width offset             | m <sup>WWN</sup>       | 0              |
| WWL       | Coefficient of length and width cross term for width offset             | m <sup>WLN+WW</sup>    | v <sub>0</sub> |
| WWLC      | Coefficient of length and width dependence for CV channel width offset  | m <sup>WLN+WW</sup>    | v <sub>0</sub> |
| WWN       | Power of width dependence of width offset                               | _                      | 1              |
| XJ        | Junction depth  | m                      | 0              |
|           | Resistance Parameters   |                        |                |
| RSH       | Drain, source diffusion sheet resistance                                | Ω                      | 0              |
|           | Process Parameters  |                        |                |
| GAMMA1    | Body effect coefficient near the surface                                | $V^{1/2}$              | 0              |
| GAMMA2    | Body effect coefficient in the bulk                                     | $V^{1/2}$              | 0              |
| NCH       | Channel doping concentration  | $cm^{-3}$              | 1.7e+17        |
| TBOX      | Buried oxide thickness  | m                      | 3e-07          |
| TOXM      | Gate oxide thickness used in extraction                                 | m                      | 0              |
| TSI       | Silicon film thickness  | m                      | 1e-07          |
| U0        | Surface mobility  | 1/(Vcm <sup>2</sup> s) | 0              |
| VBX       | Vbs at which the depetion region = XT                                   | V                      | 0              |

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter  | Description   | Units                 | Default              |
|------------|---|-----------------------|----------------------|
| XT         | Doping depth  | m                     | 1.55e-07             |
|            | RF Parameters   |                       |                      |
| BUG1830FIX | Voltage limter fix for bug 1830   | _                     | 0                    |
| NGCON      | Number of gate contacts   | _                     | 1                    |
| RGATEMOD   | Gate resistance model selector  | _                     | 0                    |
| XGL        | Offset of the gate length due to variations in patterning                                       | m                     | 0                    |
| XGW        | Distance from the gate contact to the channel edge  | m                     | 0                    |
| XRCRG1     | Parameter for distributed channel resistance effect for intrinsic input resistance              | _                     | 12                   |
| XRCRG2     | Parameter to account for the excess channel diffusion resistance for intrinsic input resistance | -                     | 1                    |
|            | Temperature Parameters  |                       |                      |
| AT         | Temperature coefficient for saturation velocity   | m/s                   | 33000                |
| CTH0       | Thermal capacitance per unit width  | F/m                   | 1e-05                |
| KT1        | Temperature coefficient for threshold voltage   | V                     | -0.11                |
| KT1L       | Channel length dependence of the temerature coefficient for the threshold voltage               | Vm                    | 0                    |
| KT2        | Body-bias coefficient fo the threshold voltage temperature effect                               | -                     | 0.022                |
| NTRECF     | Temperature coefficient for NRECF   | _                     | 0                    |
| NTRECR     | Temperature coefficient for NRECR   | _                     | 0                    |
| PRT        | Temerature coefficient for RDSW   | Ω μm                  | 0                    |
| RTH0       | Thermal resistance per unit width   | $\Omega/m$            | 0                    |
| TCJSWG     | Temperature coefficient of Cjswg  | $K^{-1}$              | 0                    |
| TNOM       | Nominal device temperature  | °C                    | Ambient<br>Temperatu |
| TPBSWG     | Temperature coefficient of Pbswg  | V/K                   | 0                    |
| UA1        | Temperature coefficient for UA  | m/V                   | 4.31e-09             |
| UB1        | Temperature coefficient for UB  | $m^2/V^2$             | -7.61e-18            |
| UC1        | Temperature coefficient for UC  | m/(°CV <sup>2</sup> ) | 0                    |
| UTE        | Mobility temerature exponent  | _                     | -1.5                 |
| WTHO       | Minimum width for thermal resistance calculation  | m                     | 0                    |
| XBJT       | Power dependence of JBJT on temperature   | _                     | 1                    |
| XDIF       | Power dependence of JDIF on temperature   | _                     | 0                    |
| XREC       | Power dependence of JREC on temperature   | _                     | 1                    |
| XTUN       | Power dependence of JTUN on temperature   | _                     | 0                    |

**Tunnelling Parameters** 

Table 2-101. BSIM3 SOI Device Model Parameters

| Parameter | Description  | Units    | Default |
|-----------|--|----------|---------|
| ALPHAGB1  | First Vox dependent parameter for gate current in inversion  | $V^{-1}$ | 0.35    |
| ALPHAGB2  | First Vox dependent parameter for gate current in accumulation                                       | $V^{-1}$ | 0.43    |
| BETAGB1   | Second Vox dependent parameter for gate current in inversion   | $V^{-2}$ | 0.03    |
| BETAGB2   | First Vox dependent parameter for gate current in accumulation                                       | $V^{-2}$ | 0.05    |
| EBG       | Effective bandgap in gate current calculation  | V        | 1.2     |
| IGMOD     | Gate current model selector  | -        | 0       |
| NTOX      | Power term of gate current   | _        | 1       |
| TOXQM     | Oxide thickness for Igb calculation  | m        | 0       |
| TOXREF    | Target oxide thickness   | m        | 2.5e-09 |
| VECB      | Vaux parameter for conduction band electron tunneling  | _        | 0.026   |
| VEVB      | Vaux parameter for valence band electron tunneling   | _        | 0.075   |
| VGB1      | Third Vox dependent parameter for gate current in inversion  | V        | 300     |
| VGB2      | Third Vox dependent parameter for gate current in accumulation                                       | V        | 17      |
|           | Built-in Potential Lowering Parameters   |          |         |
| DK2B      | Third backgate body effect parameter for short channel effect  | _        | 0       |
| DVBD0     | First short channel effect parameter in FD module  | _        | 0       |
| DVBD1     | Second short channel effect parameter in FD module   | _        | 0       |
| K1B       | First backgate body effect parameter   | _        | 1       |
| K2B       | Second backgate body effect parameter for short channel effect                                       | _        | 0       |
| MOINFD    | Gate bias dependance coefficient of surface potential in FD module                                   | _        | 1000    |
| NOFFFD    | Smoothing parameter in FD module   | _        | 1       |
| SOIMOD    | SIO model selector,SOIMOD=0:<br>BSIMPD,SOIMOD=1: undefined model for PD and<br>FE,SOIMOD=2: ideal FD | _        | 0       |
| VBSA      | Offset voltage due to non-idealities   | V        | 0       |
| VOFFFD    | Smoothing parameter in FD module   | V        | 0       |

## 2.3.20.7. Level 14/54 MOSFET Tables (BSIM4)

The level 14 MOSFET device in Xyce is based on the Berkeley BSIM4 model version 4.6.1. (For HSPICE compatibility, the Xyce BSIM4 model can also be specified as level 54.) The model's parameters are given in the following tables. Note that the parameters have not all been properly categorized with units in place. For complete documentation of the BSIM4 model, see the BSIM4 User's Manual, available for download at http://bsim.berkeley.edu/models/bsim4/.

Table 2-102. BSIM4 Device Instance Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| AD        | Drain area   | _     | 0       |
| AS        | Source area  | _     | 0       |
| IC2       |  | _     | 0       |
| IC3       |  | _     | 0       |
| L         | Length   | _     | 5e-06   |
| М         | Number of parallel copies  | _     | 1       |
| MIN       | Minimize either D or S   | _     | 0       |
| NF        | Number of fingers  | _     | 1       |
| NGCON     | Number of gate contacts  | _     | 0       |
| OFF       | Device is initially off  | _     | false   |
| PD        | Drain perimeter  | _     | 0       |
| PS        | Source perimeter   | _     | 0       |
| RBDB      | Body resistance  | _     | 0       |
| RBPB      | Body resistance  | _     | 0       |
| RBPD      | Body resistance  | _     | 0       |
| RBPS      | Body resistance  | _     | 0       |
| RBSB      | Body resistance  | _     | 0       |
| SA        | distance between OD edge to poly of one side                           | _     | 0       |
| SB        | distance between OD edge to poly of the other side                     | _     | 0       |
| SC        | Distance to a single well edge   | _     | 0       |
| SCA       | Integral of the first distribution function for scattered well dopant  | _     | 0       |
| SCB       | Integral of the second distribution function for scattered well dopant | -     | 0       |
| SCC       | Integral of the third distribution function for scattered well dopant  | -     | 0       |
| SD        | distance between neighbour fingers                                     | _     | 0       |
| W         | Width  | _     | 5e-06   |
| XGW       | Distance from gate contact center to device edge                       | _     | 0       |
|           | Basic Parameters   |       |         |

346

**Table 2-102. BSIM4 Device Instance Parameters** 

| Parameter | Description  | Units | Default                |
|-----------|--|-------|------------------------|
| DELVTO    | Zero bias threshold voltage variation                    | V     | 0                      |
|           | Control Parameters                                       |       |                        |
| ACNQSMOD  | AC NQS model selector                                    | -     | 0                      |
| GEOMOD    | Geometry dependent parasitics model selector             | -     | 0                      |
| RBODYMOD  | Distributed body R model selector                        | _     | 0                      |
| RGATEMOD  | Gate resistance model selector                           | _     | 0                      |
| RGEOMOD   | S/D resistance and contact model selector                | _     | 0                      |
| TRNQSMOD  | Transient NQS model selector                             | _     | 0                      |
|           | Temperature Parameters                                   |       |                        |
| TEMP      | Device temperature                                       | °C    | Ambient<br>Temperature |
|           | Voltage Parameters                                       |       |                        |
| IC1       | Vector of initial values: Vds,Vgs,Vbs                    | V     | 0                      |
|           | Asymmetric and Bias-Dependent R <sub>ds</sub> Parameters |       |                        |
| NRD       | Number of squares in drain                               | _     | 1                      |
| NRS       | Number of squares in source                              | _     | 1                      |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| AF        | Flicker noise exponent  | _     | 1       |
| AIGSD     | Parameter for Igs,d   | _     | 0.0136  |
| AT        | Temperature coefficient of vsat                                 | _     | 33000   |
| BIGSD     | Parameter for Igs,d   | _     | 0.00171 |
| BVD       | Drain diode breakdown voltage                                   | _     | 10      |
| BVS       | Source diode breakdown voltage                                  | _     | 10      |
| CIGSD     | Parameter for Igs,d   | _     | 0.075   |
| CJD       | Drain bottom junction capacitance per unit area                 | _     | 0.0005  |
| CJS       | Source bottom junction capacitance per unit area                | _     | 0.0005  |
| CJSWD     | Drain sidewall junction capacitance per unit periphery          | _     | 5e-10   |
| CJSWGD    | Drain (gate side) sidewall junction capacitance per unit width  | _     | 0       |
| CJSWGS    | Source (gate side) sidewall junction capacitance per unit width | _     | 0       |
| CJSWS     | Source sidewall junction capacitance per unit periphery         | _     | 5e-10   |
| DLCIG     | Delta L for Ig model  | -     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description  | Units         | Default |
|-----------|--|---------------|---------|
| DMCG      | Distance of Mid-Contact to Gate edge                                       | _             | 0       |
| DMCGT     | Distance of Mid-Contact to Gate edge in Test structures                    | -             | 0       |
| DMCI      | Distance of Mid-Contact to Isolation                                       | _             | 0       |
| DMDG      | Distance of Mid-Diffusion to Gate edge                                     | _             | 0       |
| DWJ       | Delta W for S/D junctions  | -             | 0       |
| EF        | Flicker noise frequency exponent   | _             | 1       |
| EM        | Flicker noise parameter  | _             | 4.1e+07 |
| EPSRGATE  | Dielectric constant of gate relative to vacuum                             | _             | 11.7    |
| GBMIN     | Minimum body conductance   | $\Omega^{-1}$ | 1e-12   |
| IJTHDFWD  | Forward drain diode forward limiting current                               | _             | 0.1     |
| IJTHDREV  | Reverse drain diode forward limiting current                               | _             | 0.1     |
| IJTHSFWD  | Forward source diode forward limiting current                              | _             | 0.1     |
| IJTHSREV  | Reverse source diode forward limiting current                              | _             | 0.1     |
| JSD       | Bottom drain junction reverse saturation current density                   | -             | 0.0001  |
| JSS       | Bottom source junction reverse saturation current density                  | _             | 0.0001  |
| JSWD      | Isolation edge sidewall drain junction reverse saturation current density  | _             | 0       |
| JSWGD     | Gate edge drain junction reverse saturation current density                | _             | 0       |
| JSWGS     | Gate edge source junction reverse saturation current density               | -             | 0       |
| JSWS      | Isolation edge sidewall source junction reverse saturation current density | -             | 0       |
| JTSD      | Drain bottom trap-assisted saturation current density                      | _             | 0       |
| JTSS      | Source bottom trap-assisted saturation current density                     | _             | 0       |
| JTSSWD    | Drain STI sidewall trap-assisted saturation current density                | -             | 0       |
| JTSSWGD   | Drain gate-edge sidewall trap-assisted saturation current density          | -             | 0       |
| JTSSWGS   | Source gate-edge sidewall trap-assisted saturation current density         | -             | 0       |
| JTSSWS    | Source STI sidewall trap-assisted saturation current density               | _             | 0       |
| K2WE      | K2 shift factor for well proximity effect                                  | _             | 0       |
| K3B       | Body effect coefficient of k3  | _             | 0       |
| KF        | Flicker noise coefficient  | _             | 0       |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| KT1       | Temperature coefficient of Vth                                | _     | -0.11   |
| KT1L      | Temperature coefficient of Vth                                | _     | 0       |
| KT2       | Body-coefficient of kt1                                       | _     | 0.022   |
| KU0       | Mobility degradation/enhancement coefficient for LOD          | _     | 0       |
| KU0WE     | Mobility degradation factor for well proximity effect         | _     | 0       |
| KVSAT     | Saturation velocity degradation/enhancement parameter for LOD | _     | 0       |
| KVTH0     | Threshold degradation/enhancement parameter for LOD           | _     | 0       |
| KVTH0WE   | Threshold shift factor for well proximity effect              | _     | 0       |
| LA0       | Length dependence of a0                                       | _     | 0       |
| LA1       | Length dependence of a1                                       | _     | 0       |
| LA2       | Length dependence of a2                                       | _     | 0       |
| LACDE     | Length dependence of acde                                     | _     | 0       |
| LAGIDL    | Length dependence of agidl                                    | _     | 0       |
| LAGISL    | Length dependence of agisl                                    | _     | 0       |
| LAGS      | Length dependence of ags                                      | -     | 0       |
| LAIGBACC  | Length dependence of aigbacc                                  | _     | 0       |
| LAIGBINV  | Length dependence of aigbinv                                  | _     | 0       |
| LAIGC     | Length dependence of aigc                                     | _     | 0       |
| LAIGD     | Length dependence of aigd                                     | _     | 0       |
| LAIGS     | Length dependence of aigs                                     | _     | 0       |
| LAIGSD    | Length dependence of aigsd                                    | _     | 0       |
| LALPHA0   | Length dependence of alpha0                                   | _     | 0       |
| LALPHA1   | Length dependence of alpha1                                   |       | 0       |
| LAT       | Length dependence of at                                       | _     | 0       |
| LB0       | Length dependence of b0                                       | _     | 0       |
| LB1       | Length dependence of b1                                       | _     | 0       |
| LBETA0    | Length dependence of beta0                                    | _     | 0       |
| LBGIDL    | Length dependence of bgidl                                    |       | 0       |
| LBGISL    | Length dependence of bgisl                                    | _     | 0       |
| LBIGBACC  | Length dependence of bigbacc                                  |       | 0       |
| LBIGBINV  | Length dependence of bigbinv                                  | _     | 0       |
| LBIGC     | Length dependence of bigc                                     | _     | 0       |
| LBIGD     | Length dependence of bigd                                     | _     | 0       |
|           |   |       |         |

Table 2-103. BSIM4 Device Model Parameters

| Parameter    | Description                   | Units | Default |
|--------------|-------------------------------|-------|---------|
| LBIGSD       | Length dependence of bigsd    |       | 0       |
| LCDSC        | Length dependence of cdsc     | _     | 0       |
| LCDSCB       | Length dependence of cdscb    | _     | 0       |
| LCDSCD       | Length dependence of cdscd    | _     | 0       |
| LCF          | Length dependence of cf       | _     | 0       |
| LCGDL        | Length dependence of cgdl     | _     | 0       |
| LCGIDL       | Length dependence of cgidl    | _     | 0       |
| LCGISL       | Length dependence of cgisl    | _     | 0       |
| LCGSL        | Length dependence of cgsl     | _     | 0       |
| LCIGBACC     | Length dependence of cigbacc  | _     | 0       |
| LCIGBINV     | Length dependence of cigbinv  | _     | 0       |
| LCIGC        | Length dependence of cigc     |       | 0       |
| LCIGD        | Length dependence of cigd     |       | 0       |
| LCIGS        | Length dependence of cigs     |       | 0       |
| LCIGSD       | Length dependence of cigsd    | _     | 0       |
| LCIT         | Length dependence of cit      | _     | 0       |
| LCKAPPAD     | Length dependence of ckappad  | _     | 0       |
| LCKAPPAS     | Length dependence of ckappas  | _     | 0       |
| LCLC         | Length dependence of clc      | _     | 0       |
| LCLE         | Length dependence of cle      | _     | 0       |
| LDELTA       | Length dependence of delta    | _     | 0       |
| LDROUT       | Length dependence of drout    | _     | 0       |
| LDSUB        | Length dependence of dsub     | _     | 0       |
| LDVT0        | Length dependence of dvt0     | _     | 0       |
| LDVT0W       | Length dependence of dvt0w    | _     | 0       |
| LDVT1        | Length dependence of dvt1     | _     | 0       |
| LDVT1W       | Length dependence of dvt1w    | _     | 0       |
| LDVT2        | Length dependence of dvt2     | _     | 0       |
| LDVT2W       | Length dependence of dvt2w    | _     | 0       |
| LDVTP0       | Length dependence of dvtp0    | _     | 0       |
| LDVTP1       | Length dependence of dvtp1    | _     | 0       |
| LDWB         | Length dependence of dwb      | _     | 0       |
| LDWG         | Length dependence of dwg      | _     | 0       |
| LEGIDL       | Length dependence of egidl    | _     | 0       |
| LEGISL       | Length dependence of egisl    | _     | 0       |
| <br>LEIGBINV | Length dependence for eigbinv |       | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| LETAO         Length dependence of etab         -         0           LETU         Length dependence of etab         -         0           LEFRACUT         Length dependence of eu         -         0           LEFRACUT         Length dependence of pdibleb         -         0           LEFRACUT         Length dependence of gammal         -         0           LGAMMA2         Length dependence of gammal         -         0           LKI         Length dependence of kl         -         0           LKI         Length dependence of kl         -         0           LK2         Length dependence of kl         -         0           LK2         Length dependence of kl         -         0           LK2         Length dependence of kl         -         0           LK3         Length dependence of kl         -         0           LK3         Length dependence of kl         -         0           LK7         Length dependence of kl1         -         0           LK71         Length dependence of kl1         -         0           LK72         Length dependence of kl0         -         0           LK70         Length dependence of kl0         -  | Parameter | Description                         | Units | Default |
|--|-----------|-------------------------------------|-------|---------|
| LEU         Length dependence of eu         -         0           LFPROUT         Length dependence of pdibleb         -         0           LGAMMA1         Length dependence of gamma1         -         0           LGAMMA2         Length dependence of gamma2         -         0           LINTNOT         lint offset for noise calculation         -         0           LK1         Length dependence of k1         -         0           LK2         Length dependence of k2         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k3         -         0           LK41         Length dependence of k1         -         0           LK71         Length dependence of k1         -         0           LK71         Length dependence of k1         -         0           LK71         Length dependence of k10         -         0           LK71         Length dependence of k10         -   | LETA0     | Length dependence of eta0           | _     | 0       |
| LEPROUT Length dependence of pdiblob - 0  LGAMMA1 Length dependence of gamma1 - 0  LGAMMA2 Length dependence of gamma2 - 0  LINTNOI lint offset for noise calculation - 0  LK1 Length dependence of k1 - 0  LK2 Length dependence of k2 - 0  LK2WE Length dependence of k2 - 0  LK3 Length dependence of k3 - 0  LK3 Length dependence of k3 - 0  LK3B Length dependence of k3 - 0  LK3B Length dependence of k3 - 0  LK4BETA Length dependence of k8 - 0  LK71 Length dependence of k1 - 0  LK72 Length dependence of k1 - 0  LK72 Length dependence of k1 - 0  LK70 LENGT Length dependence of k1 - 0  LKY1 Length dependence of k1 - 0  LKY2 Length dependence of k1 - 0  LKY0 Length dependence of k1 - 0  LKY0 Length dependence of k10 - 0  LKUOWE Length dependence of k10 - 0  LKVTHO Length dependence of k10 - 0  LKVTHO Length dependence of k10 - 0  LKVTHOWE Length dependence of k10 - 0  LL LENGT Length reduction parameter - 0  LL Length reduction parameter or ULOD effect - 0  LLODVID Length parameter for ULOD effect - 0  LLODVID Length parameter for ULOD effect - 0  LLODVID Length parameter for ULOD effect - 0  LLODVID Length dependence of lpe0 - 0  LLP Length dependence of lpe0 - 0  LLP Length dependence of lpe0 - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINV Length dependence of minv - 0  LMINVCV Length dependence of minvc - 0  LMOIN Length dependence of minvc - 0 | LETAB     | Length dependence of etab           | -     | 0       |
| LGAMMA1         Length dependence of gamma2         -         0           LGAMMA2         Length dependence of gamma2         -         0           LINTNOI         lint offset for noise calculation         -         0           LK1         Length dependence of k1         -         0           LK2         Length dependence of k2         -         0           LK2WE         Length dependence of k2we         -         0           LK2WE         Length dependence of k3         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k4b         -         0           LKT1         Length dependence of kt1         -         0           LKT1         Length dependence of k1         -         0           LKT2         Length dependence of k1         -         0           LKU0         Length dependence of k10         -         0           LKU0         Length dependence of k10         -         0           LKVTHO         Length dependence of k10         -         0           LKVTHO         Length dependence of k10         -         0           LKVTHOWE         Length dependence of k10         <  | LEU       | Length dependence of eu             | _     | 0       |
| LGAMMA2         Length dependence of gamma2         -         0           LINTNOI         lint offset for noise calculation         -         0           LK1         Length dependence of k1         -         0           LK2         Length dependence of k2         -         0           LK2         Length dependence of k2ee         -         0           LK2         Length dependence of k2ee         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k3b         -         0           LK81A         Length dependence of k4b         -         0           LKT1         Length dependence of k1l         -         0           LKT1         Length dependence of k1l         -         0           LKT2         Length dependence of k1l         -         0           LKU0         Length dependence of k10         -         0           LKV10         Length dependence of k10         -         0           LKV1HO         Length dependence of k10         -         0           LKV1HO         Length reduction parameter         -         0           LKV7HOWE         Length reduction parameter         <  | LFPROUT   | Length dependence of pdiblcb        | _     | 0       |
| LINTNOI         lint offset for noise calculation         -         0           LK1         Length dependence of k1         -         0           LK2         Length dependence of k2         -         0           LK2WE         Length dependence of k2         -         0           LKWE         Length dependence of k3         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k8b         -         0           LKETA         Length dependence of kta         -         0           LKT1         Length dependence of kt1         -         0           LKT1L         Length dependence of k11         -         0           LKT2         Length dependence of k11         -         0           LKU2         Length dependence of k10         -         0           LKV1B         Length dependence of k10         -         0           LKVTHO         Length dependence of kv10         -         0           LKVTHOWE         Length dependence of kv10         -         0           LKVTHOWE         Length dependence of kv10         -         0           LLYTHOWE         Length dependence of w10 <t< td=""><td>LGAMMA1</td><td>Length dependence of gamma1</td><td>_</td><td>0</td></t<>   | LGAMMA1   | Length dependence of gamma1         | _     | 0       |
| LK1         Length dependence of k1         -         0           LK2         Length dependence of k2         -         0           LK2WE         Length dependence of k2we         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k3b         -         0           LKT1         Length dependence of keta         -         0           LKT1         Length dependence of k1l         -         0           LKT2         Length dependence of k1l         -         0           LKU0         Length dependence of k20         -         0           LKU00         Length dependence of k00         -         0           LKUTHO         Length dependence of k0we         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLAMBDA         Length dependence of lambda         -         0           LLC         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for W <td>LGAMMA2</td> <td>Length dependence of gamma2</td> <td>_</td> <td>0</td>  | LGAMMA2   | Length dependence of gamma2         | _     | 0       |
| LK2         Length dependence of k2we         -         0           LK2WE         Length dependence of k2we         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k3b         -         0           LKETA         Length dependence of keta         -         0           LKT1         Length dependence of k1l         -         0           LKT1L         Length dependence of k1l         -         0           LKT2         Length dependence of k1l         -         0           LKU00         Length dependence of k00         -         0           LKU00         Length dependence of k0we         -         0           LKVTH0         Length dependence of kvth0we         -         0           LKVTH0WE         Length dependence of kvth0we         -         0           LLA         Length reduction parameter         -         0           LLA         Length dependence of lambda         -         0           LLC         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for W         -         0           LLO         Length reduction parameter f   | LINTNOI   | lint offset for noise calculation   | _     | 0       |
| LK2WE         Length dependence of k2we         -         0           LK3         Length dependence of k3         -         0           LK3B         Length dependence of k3b         -         0           LKETA         Length dependence of keta         -         0           LKT1         Length dependence of kt1         -         0           LKT2         Length dependence of kt1         -         0           LKU0         Length dependence of ku0         -         0           LKU0WE         Length dependence of ku0we         -         0           LKVTHO         Length dependence of kv1h0         -         0           LKVTHOWE         Length dependence of kv1h0we         -         0           LL         Length reduction parameter         -         0           LLAMEDA         Length reduction parameter         -         0           LLAMEDA         Length reduction parameter for CV         -         0           LLA         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for v0 LOD effect         -         0           LLODKU0         Length parameter for v1 LOD effect         -         0           LLODVTH   | LK1       | Length dependence of k1             | _     | 0       |
| LK3         Length dependence of k3b         -         0           LK3B         Length dependence of k3b         -         0           LKETA         Length dependence of keta         -         0           LKT1         Length dependence of kt1         -         0           LKT1L         Length dependence of kt1         -         0           LKT2         Length dependence of kt2         -         0           LKU0         Length dependence of ku0         -         0           LKU0WE         Length dependence of ku0we         -         0           LKVTH0         Length dependence of kvth0         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLA         Length dependence of lambda         -         0           LL         Length reduction parameter for CV         -         0           LL         Length reduction parameter for ULOD effect         -         0           LLODKU0         Length parameter for vh LOD effect         -         0           LLPE         Length dependence of lp0         -         0           LLPED         Length d   | LK2       | Length dependence of k2             | _     | 0       |
| LK3B         Length dependence of k3b         -         0           LKETA         Length dependence of keta         -         0           LKT1         Length dependence of kt1         -         0           LKT1L         Length dependence of kt1l         -         0           LKT2         Length dependence of kt2         -         0           LKU0         Length dependence of ku0         -         0           LKUUWE         Length dependence of ku0we         -         0           LKVTHO         Length dependence of kvth0we         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLAMBDA         Length dependence of lambda         -         0           LLC         Length reduction parameter for CV         -         0           LLN         Length reduction parameter for CV         -         0           LLD         Length parameter for ub LOD effect         -         0           LLODKUO         Length parameter for vth LOD effect         -         0           LLPEO         Length dependence of lpe0         -         0           LMAX  | LK2WE     | Length dependence of k2we           | -     | 0       |
| LKETA         Length dependence of keta         -         0           LKT1         Length dependence of kt1         -         0           LKT1L         Length dependence of kt1         -         0           LKT2         Length dependence of kt2         -         0           LKU0         Length dependence of ku0         -         0           LKU0WE         Length dependence of ku0we         -         0           LKVTHO         Length dependence of kvth0         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLA         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for UDD effect         -         0           LLO         Length parameter for u0 LOD effect         -         0           LLO         Length parameter for vth LOD effect         -         0           LLP         Length dependence of lpe0         -         0           LLPEB <td>LK3</td> <td>Length dependence of k3</td> <td>_</td> <td>0</td>  | LK3       | Length dependence of k3             | _     | 0       |
| LKT1         Length dependence of kt1         -         0           LKT1L         Length dependence of kt1         -         0           LKT2         Length dependence of kt2         -         0           LKU0         Length dependence of ku0         -         0           LKU0WE         Length dependence of ku0we         -         0           LKVTH0         Length dependence of kvth0         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLAMBDA         Length dependence of lambda         -         0           LLO         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for VV         -         0           LLO         Length parameter for u0 LOD effect         -         0           LLODKU0         Length parameter for vth LOD effect         -         0           LLPE         Length dependence of lpe0         -         0           LLPEB         Length dependence of lpe0         -         0           LMAX         Maximum length for the model         -         0           LMINV   | LK3B      | Length dependence of k3b            | _     | 0       |
| LKT1L         Length dependence of ktll         -         0           LKT2         Length dependence of ktl         -         0           LKU0         Length dependence of ku0         -         0           LKU0WE         Length dependence of ku0we         -         0           LKVTHO         Length dependence of kvth0         -         0           LKVTHOWE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLAMBDA         Length dependence of lambda         -         0           LLC         Length reduction parameter         -         0           LLO         Length reduction parameter for CV         -         0           LLO         Length reduction parameter for UDD effect         -         0           LLODKUO         Length parameter for u0 LOD effect         -         0           LLODVIH         Length parameter for vth LOD effect         -         0           LLP         Length dependence of lpe0         -         0           LLPEB         Length dependence of lpe0         -         0           LMAX         Maximum length for the model         -         1           LMINV  | LKETA     | Length dependence of keta           | _     | 0       |
| LKT2 Length dependence of kt2 - 0  LKU0 Length dependence of ku0 - 0  LKU0WE Length dependence of ku0we - 0  LKVTHO Length dependence of kvthO - 0  LKVTHOWE Length dependence of kvthOwe - 0  LL Length dependence of kvthOwe - 0  LL Length dependence of kvthOwe - 0  LL Length dependence of lambda - 0  LLO Length reduction parameter - 0  LLO Length reduction parameter for CV - 0  LLN Length reduction parameter - 1  LLODKUO Length parameter for U LOD effect - 0  LLODVTH Length parameter for vth LOD effect - 0  LLPE Length dependence of lpe - 0  LLPE Length dependence of lpe0 - 0  LLPE Length dependence of lpe0 - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINV Length dependence of minv - 0  LMINVCV Length dependence of minvcv - 0  LMOIN Length dependence of minvcv - 0  LMOIN Length dependence of ndep - 0  LNDEP Length dependence of minvcv - 0  LMOIN Length dependence of minvcv - 0  LMOIN Length dependence of minvcv - 0  LMOIN Length dependence of minvcv - 0  LMDEP Length dependence of minvcv - 0  LMDEP Length dependence of minvcv - 0   | LKT1      | Length dependence of kt1            | _     | 0       |
| LKU0         Length dependence of ku0         -         0           LKU0WE         Length dependence of ku0we         -         0           LKVTH0         Length dependence of kvth0         -         0           LKVTH0WE         Length dependence of kvth0we         -         0           LL         Length reduction parameter         -         0           LLAMEDA         Length dependence of lambda         -         0           LLC         Length reduction parameter for CV         -         0           LLN         Length reduction parameter for CV         -         0           LLN         Length reduction parameter for UDD effect         -         0           LLODKU0         Length parameter for vth LOD effect         -         0           LLODVTH         Length dependence of lp         -         0           LLPE         Length dependence of lpe0         -         0           LLPED         Length dependence of lpe0         -         0           LMAX         Maximum length for the model         -         0           LMIN         Minimum length for the model         -         0           LMINV         Length dependence of minv         -         0           LMIN  | LKT1L     | Length dependence of kt1l           | _     | 0       |
| LKUOWE       Length dependence of ku0we       -       0         LKVTHO       Length dependence of kvthOwe       -       0         LKVTHOWE       Length dependence of kvthOwe       -       0         LL       Length reduction parameter       -       0         LLAMBDA       Length dependence of lambda       -       0         LLC       Length reduction parameter for CV       -       0         LLN       Length reduction parameter       -       1         LLODKUO       Length parameter for u0 LOD effect       -       0         LLODVTH       Length dependence of lp       -       0         LLPE       Length dependence of lpe0       -       0         LLPEO       Length dependence of lpe0       -       0         LMAX       Maximum length for the model       -       1         LMIN       Minimum length for the model       -       0         LMINV       Length dependence of minv       -       0         LMINVCV       Length dependence of minvcv       -       0         LMOIN       Length dependence of moin       -       0         LMOEP       Length dependence of ndep       -       0   | LKT2      | Length dependence of kt2            | -     | 0       |
| LKVTHO       Length dependence of kvthOwe       -       0         LKVTHOWE       Length dependence of kvthOwe       -       0         LL       Length reduction parameter       -       0         LLAMBDA       Length dependence of lambda       -       0         LLC       Length reduction parameter for CV       -       0         LLN       Length reduction parameter       -       1         LLODKUO       Length parameter for u0 LOD effect       -       0         LLODVTH       Length parameter for vth LOD effect       -       0         LLP       Length dependence of lp       -       0         LLPEO       Length dependence of lpe0       -       0         LMAX       Maximum length for the model       -       0         LMIN       Minimum length for the model       -       0         LMINV       Length dependence of minv       -       0         LMINVCV       Length dependence of minvcv       -       0         LMOIN       Length dependence of moin       -       0         LMOEP       Length dependence of ndep       -       0  | LKU0      | Length dependence of ku0            | _     | 0       |
| LKVTHOWE Length dependence of kvthOwe - 0  LL Length reduction parameter - 0  LLAMBDA Length dependence of lambda - 0  LLC Length reduction parameter for CV - 0  LLN Length reduction parameter - 1  LLODKUO Length parameter for u0 LOD effect - 0  LLODVTH Length parameter for vth LOD effect - 0  LLPE Length dependence of lpe - 0  LLPEO Length dependence of lpe0 - 0  LLPEB Length dependence of lpeb - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINV Length dependence of minvcv - 0  LMOIN Length dependence of minvcv - 0  LMOIN Length dependence of ndep - 0  LMOIN Length dependence of ndep - 0  | LKU0WE    | Length dependence of ku0we          | _     | 0       |
| LLAMBDA Length dependence of lambda - 0  LLC Length reduction parameter for CV - 0  LLN Length reduction parameter for CV - 1  LLODKUO Length parameter for u0 LOD effect - 0  LLODVTH Length parameter for vth LOD effect - 0  LLP Length dependence of lp - 0  LLPE Length dependence of lpe0 - 0  LLPEB Length dependence of lpe0 - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINV Length dependence of minv - 0  LMINVCV Length dependence of minvcv - 0  LMOIN Length dependence of moin - 0  LMOIN Length dependence of moin - 0  LMOIN Length dependence of moin - 0  LMOIN Length dependence of ndep - 0  | LKVTH0    | Length dependence of kvth0          | _     | 0       |
| LLAMBDA Length dependence of lambda – 0  LLC Length reduction parameter for CV – 0  LLN Length reduction parameter — 1  LLODKUO Length parameter for u0 LOD effect – 0  LLODVTH Length parameter for vth LOD effect – 0  LLPE Length dependence of lp – 0  LLPEO Length dependence of lpeO – 0  LLPEB Length dependence of lpeO – 0  LMAX Maximum length for the model – 1  LMIN Minimum length for the model – 0  LMINV Length dependence of minv – 0  LMINV Length dependence of minv – 0  LMINVCV Length dependence of minvcv – 0  LMOIN Length dependence of moin – 0  LMOIN Length dependence of moin – 0  LMOIN Length dependence of ndep – 0  | LKVTH0WE  | Length dependence of kvth0we        | _     | 0       |
| LLC Length reduction parameter for CV - 0  LLN Length reduction parameter - 1  LLODKUO Length parameter for u0 LOD effect - 0  LLODVTH Length parameter for vth LOD effect - 0  LLP Length dependence of lp - 0  LLPEO Length dependence of lpeO - 0  LLPEB Length dependence of lpeb - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINVCV Length dependence of minvcv - 0  LMOIN Length dependence of moin - 0  LMOIN Length dependence of moin - 0  LMOIN Length dependence of ndep - 0   | LL        | Length reduction parameter          | _     | 0       |
| LLN       Length reduction parameter       -       1         LLODKUO       Length parameter for u0 LOD effect       -       0         LLODVTH       Length parameter for vth LOD effect       -       0         LLP       Length dependence of lp       -       0         LLPEO       Length dependence of lpe0       -       0         LMAX       Maximum length for the model       -       0         LMIN       Minimum length for the model       -       0         LMINV       Length dependence of minv       -       0         LMINVCV       Length dependence of minvcv       -       0         LMOIN       Length dependence of moin       -       0         LMOIN       Length dependence of moin       -       0         LNDEP       Length dependence of ndep       -       0  | LLAMBDA   | Length dependence of lambda         | _     | 0       |
| LLODKUO Length parameter for u0 LOD effect Length parameter for vth LOD effect Length dependence of lp LLP Length dependence of lpe0 Length dependence of lpeb Length dependence of lpeb Length dependence of lpeb Length dependence of lpeb LMAX Maximum length for the model LMIN Minimum length for the model Length dependence of minv - 0 LMINV Length dependence of minv - 0 LMINVCV Length dependence of minvcv - 0   | LLC       | Length reduction parameter for CV   | _     | 0       |
| LLODVTH Length parameter for vth LOD effect  Length dependence of lp Length dependence of lpe0  Length dependence of lpe0  Length dependence of lpeb  Length dependence of lpeb  Length dependence of lpeb  Length dependence of lpeb  LMAX Maximum length for the model  LMIN Minimum length for the model  Length dependence of minv  Length dependence of minv  Length dependence of minvev  Length dependence of moin  Length dependence of moin  Length dependence of ndep  Length dependence of ndep   | LLN       | Length reduction parameter          | _     | 1       |
| LLP         Length dependence of lpe         -         0           LLPEO         Length dependence of lpe0         -         0           LLPEB         Length dependence of lpeb         -         0           LMAX         Maximum length for the model         -         1           LMIN         Minimum length for the model         -         0           LMINV         Length dependence of minv         -         0           LMINVCV         Length dependence of minvcv         -         0           LMOIN         Length dependence of moin         -         0           LNDEP         Length dependence of ndep         -         0   | LLODKU0   | Length parameter for u0 LOD effect  | _     | 0       |
| LLPEO Length dependence of lpeO - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINVCV Length dependence of minvcv - 0  LMOIN Length dependence of moin - 0  LNDEP Length dependence of ndep - 0  | LLODVTH   | Length parameter for vth LOD effect | _     | 0       |
| LEPEB Length dependence of lpeb - 0  LMAX Maximum length for the model - 1  LMIN Minimum length for the model - 0  LMINV Length dependence of minv - 0  LMINVCV Length dependence of minvcv - 0  LMOIN Length dependence of moin - 0  LNDEP Length dependence of ndep - 0  | LLP       | Length dependence of lp             | _     | 0       |
| LMAX       Maximum length for the model       -       1         LMIN       Minimum length for the model       -       0         LMINV       Length dependence of minv       -       0         LMINVCV       Length dependence of minvcv       -       0         LMOIN       Length dependence of moin       -       0         LNDEP       Length dependence of ndep       -       0  | LLPE0     | Length dependence of lpe0           | _     | 0       |
| LMIN       Minimum length for the model       -       0         LMINV       Length dependence of minv       -       0         LMINVCV       Length dependence of minvcv       -       0         LMOIN       Length dependence of moin       -       0         LNDEP       Length dependence of ndep       -       0  | LLPEB     | Length dependence of lpeb           | _     | 0       |
| LMINV       Length dependence of minv       -       0         LMINVCV       Length dependence of minvcv       -       0         LMOIN       Length dependence of moin       -       0         LNDEP       Length dependence of ndep       -       0  | LMAX      | Maximum length for the model        | _     | 1       |
| LMINVCV     Length dependence of minvcv     -     0       LMOIN     Length dependence of moin     -     0       LNDEP     Length dependence of ndep     -     0  | LMIN      | Minimum length for the model        | _     | 0       |
| LMOIN     Length dependence of moin     -     0       LNDEP     Length dependence of ndep     -     0  | LMINV     | Length dependence of minv           | _     | 0       |
| LNDEP Length dependence of ndep – 0  | LMINVCV   | Length dependence of minvcv         | _     | 0       |
| <u> </u>   | LMOIN     | Length dependence of moin           | _     | 0       |
| LNFACTOR Length dependence of nfactor – 0  | LNDEP     | Length dependence of ndep           | _     | 0       |
|  | LNFACTOR  | Length dependence of nfactor        | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter  | Description                                      | Units | Default |
|------------|--|-------|---------|
| LNGATE     | Length dependence of ngate                       | _     | 0       |
| LNIGBACC   | Length dependence of nigbacc                     | _     | 0       |
| LNIGBINV   | Length dependence of nigbinv                     | _     | 0       |
| LNIGC      | Length dependence of nigc                        | _     | 0       |
| LNOFF      | Length dependence of noff                        | _     | 0       |
| LNSD       | Length dependence of nsd                         | _     | 0       |
| LNSUB      | Length dependence of nsub                        | _     | 0       |
| LNTOX      | Length dependence of ntox                        | -     | 0       |
| LODETA0    | eta0 shift modification factor for stress effect | -     | 1       |
| LODK2      | K2 shift modification factor for stress effect   | -     | 1       |
| LPCLM      | Length dependence of pclm                        | _     | 0       |
| LPDIBLC1   | Length dependence of pdiblc1                     | _     | 0       |
| LPDIBLC2   | Length dependence of pdiblc2                     | _     | 0       |
| LPDIBLCB   | Length dependence of pdiblcb                     | _     | 0       |
| LPDITS     | Length dependence of pdits                       | _     | 0       |
| LPDITSD    | Length dependence of pditsd                      | _     | 0       |
| LPHIN      | Length dependence of phin                        | _     | 0       |
| LPIGCD     | Length dependence for pigcd                      | _     | 0       |
| LPOXEDGE   | Length dependence for poxedge                    | _     | 0       |
| LPRT       | Length dependence of prt                         | _     | 0       |
| LPRWB      | Length dependence of prwb                        | _     | 0       |
| LPRWG      | Length dependence of prwg                        | _     | 0       |
| LPSCBE1    | Length dependence of pscbe1                      | _     | 0       |
| LPSCBE2    | Length dependence of pscbe2                      | _     | 0       |
| LPVAG      | Length dependence of pvag                        | _     | 0       |
| LRDSW      | Length dependence of rdsw                        | _     | 0       |
| LRDW       | Length dependence of rdw                         | _     | 0       |
| LRSW       | Length dependence of rsw                         | _     | 0       |
| LTVFBSDOFF | Length dependence of tvfbsdoff                   | _     | 0       |
| LTVOFF     | Length dependence of tvoff                       | _     | 0       |
| LU0        | Length dependence of u0                          | _     | 0       |
| LUA        | Length dependence of ua                          | _     | 0       |
| LUA1       | Length dependence of ua1                         | _     | 0       |
| LUB        | Length dependence of ub                          | _     | 0       |
| LUB1       | Length dependence of ub1                         | _     | 0       |
| LUC        | Length dependence of uc                          | _     | 0       |
|            |  |       |         |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LUC1      | Length dependence of uc1   | _     | 0       |
| LUD       | Length dependence of ud  | _     | 0       |
| LUD1      | Length dependence of ud1   | _     | 0       |
| LUP       | Length dependence of up  | _     | 0       |
| LUTE      | Length dependence of ute   | _     | 0       |
| LVBM      | Length dependence of vbm   | _     | 0       |
| LVBX      | Length dependence of vbx   | _     | 0       |
| LVFB      | Length dependence of vfb   | _     | 0       |
| LVFBCV    | Length dependence of vfbcv   | _     | 0       |
| LVFBSDOFF | Length dependence of vfbsdoff  | _     | 0       |
| LVOFF     | Length dependence of voff  | _     | 0       |
| LVOFFCV   | Length dependence of voffcv  | _     | 0       |
| LVSAT     | Length dependence of vsat  | _     | 0       |
| LVTH0     |  | -     | 0       |
| LVTL      | Length dependence of vtl   | _     | 0       |
| LW        | Length reduction parameter   | _     | 0       |
| LW0       | Length dependence of w0  | _     | 0       |
| LWC       | Length reduction parameter for CV                                    | _     | 0       |
| LWL       | Length reduction parameter   | _     | 0       |
| LWLC      | Length reduction parameter for CV                                    | _     | 0       |
| LWN       | Length reduction parameter   | _     | 1       |
| LWR       | Length dependence of wr  | _     | 0       |
| LXJ       | Length dependence of xj  | _     | 0       |
| LXN       | Length dependence of xn  | _     | 0       |
| LXRCRG1   | Length dependence of xrcrg1  | _     | 0       |
| LXRCRG2   | Length dependence of xrcrg2  | _     | 0       |
| LXT       | Length dependence of xt  | _     | 0       |
| MJD       | Drain bottom junction capacitance grading coefficient                | _     | 0.5     |
| MJS       | Source bottom junction capacitance grading coefficient               | _     | 0.5     |
| MJSWD     | Drain sidewall junction capacitance grading coefficient              | _     | 0.33    |
| MJSWGD    | Drain (gate side) sidewall junction capacitance grading coefficient  | -     | 0.33    |
| MJSWGS    | Source (gate side) sidewall junction capacitance grading coefficient | _     | 0.33    |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| MJSWS     | Source sidewall junction capacitance grading coefficient       | _     | 0.33    |
| NGCON     | Number of gate contacts  | _     | 1       |
| NJD       | Drain junction emission coefficient                            | _     | 1       |
| NJS       | Source junction emission coefficient                           | _     | 1       |
| NJTS      | Non-ideality factor for bottom junction                        | _     | 20      |
| NJTSD     | Non-ideality factor for bottom junction drain side             | _     | 20      |
| NJTSSW    | Non-ideality factor for STI sidewall junction                  | _     | 20      |
| NJTSSWD   | Non-ideality factor for STI sidewall junction drain side       | _     | 20      |
| NJTSSWG   | Non-ideality factor for gate-edge sidewall junction            | _     | 20      |
| NJTSSWGD  | Non-ideality factor for gate-edge sidewall junction drain side | -     | 20      |
| NTNOI     | Thermal noise parameter  | _     | 1       |
| PA0       | Cross-term dependence of a0                                    | _     | 0       |
| PA1       | Cross-term dependence of a1                                    | _     | 0       |
| PA2       | Cross-term dependence of a2                                    | _     | 0       |
| PACDE     | Cross-term dependence of acde                                  | _     | 0       |
| PAGIDL    | Cross-term dependence of agidl                                 | _     | 0       |
| PAGISL    | Cross-term dependence of agisl                                 | _     | 0       |
| PAGS      | Cross-term dependence of ags                                   | _     | 0       |
| PAIGBACC  | Cross-term dependence of aigbacc                               | _     | 0       |
| PAIGBINV  | Cross-term dependence of aigbinv                               | _     | 0       |
| PAIGC     | Cross-term dependence of aigc                                  | _     | 0       |
| PAIGD     | Cross-term dependence of aigd                                  | _     | 0       |
| PAIGS     | Cross-term dependence of aigs                                  | _     | 0       |
| PAIGSD    | Cross-term dependence of aigsd                                 | _     | 0       |
| PALPHA0   | Cross-term dependence of alpha0                                | _     | 0       |
| PALPHA1   | Cross-term dependence of alpha1                                | _     | 0       |
| PAT       | Cross-term dependence of at                                    | _     | 0       |
| PB0       | Cross-term dependence of b0                                    | _     | 0       |
| PB1       | Cross-term dependence of b1                                    | _     | 0       |
| PBD       | Drain junction built-in potential                              | -     | 1       |
| PBETA0    | Cross-term dependence of beta0                                 | _     | 0       |
| PBGIDL    | Cross-term dependence of bgidl                                 | _     | 0       |
| PBGISL    | Cross-term dependence of bgisl                                 | _     | 0       |
| PBIGBACC  | Cross-term dependence of bigbacc                               | _     | 0       |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PBIGBINV  | Cross-term dependence of bigbinv                                    | _     | 0       |
| PBIGC     | Cross-term dependence of bigc                                       | _     | 0       |
| PBIGD     | Cross-term dependence of bigd                                       | _     | 0       |
| PBIGS     | Cross-term dependence of bigs                                       | _     | 0       |
| PBIGSD    | Cross-term dependence of bigsd                                      | _     | 0       |
| PBS       | Source junction built-in potential                                  | _     | 1       |
| PBSWD     | Drain sidewall junction capacitance built in potential              | _     | 1       |
| PBSWGD    | Drain (gate side) sidewall junction capacitance built in potential  | _     | 0       |
| PBSWGS    | Source (gate side) sidewall junction capacitance built in potential | _     | 0       |
| PBSWS     | Source sidewall junction capacitance built in potential             | _     | 1       |
| PCDSC     | Cross-term dependence of cdsc                                       | _     | 0       |
| PCDSCB    | Cross-term dependence of cdscb                                      |       | 0       |
| PCDSCD    | Cross-term dependence of cdscd                                      |       | 0       |
| PCF       | Cross-term dependence of cf   | _     | 0       |
| PCGDL     | Cross-term dependence of cgdl                                       | _     | 0       |
| PCGIDL    | Cross-term dependence of cgidl                                      | _     | 0       |
| PCGISL    | Cross-term dependence of cgisl                                      | _     | 0       |
| PCGSL     | Cross-term dependence of cgsl                                       | _     | 0       |
| PCIGBACC  | Cross-term dependence of cigbacc                                    | _     | 0       |
| PCIGBINV  | Cross-term dependence of cigbinv                                    | _     | 0       |
| PCIGC     | Cross-term dependence of cigc                                       | _     | 0       |
| PCIGD     | Cross-term dependence of cigd                                       | _     | 0       |
| PCIGS     | Cross-term dependence of cigs                                       | _     | 0       |
| PCIGSD    | Cross-term dependence of cigsd                                      |       | 0       |
| PCIT      | Cross-term dependence of cit  | _     | 0       |
| PCKAPPAD  | Cross-term dependence of ckappad                                    | _     | 0       |
| PCKAPPAS  | Cross-term dependence of ckappas                                    | _     | 0       |
| PCLC      | Cross-term dependence of clc  | _     | 0       |
| PCLE      | Cross-term dependence of cle  | _     | 0       |
| PDELTA    | Cross-term dependence of delta                                      |       | 0       |
| PDROUT    | Cross-term dependence of drout                                      |       | 0       |
| PDSUB     | Cross-term dependence of dsub                                       |       | 0       |
| PDVT0     | Cross-term dependence of dvt0                                       |       | 0       |
| PDVT0W    | Cross-term dependence of dvt0w                                      | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| PDVT1         Cross-term dependence of dvtl         -         0           PDVT2         Cross-term dependence of dvtl         -         0           PDVT2W         Cross-term dependence of dvt2w         -         0           PDVT2W         Cross-term dependence of dvtp0         -         0           PDVTP0         Cross-term dependence of dvtp1         -         0           PDWB         Cross-term dependence of dvtp1         -         0           PDWB         Cross-term dependence of dvg         -         0           PEGIDL         Cross-term dependence of evgl         -         0           PETAB         Cross-term dependence of evgl         -         0           PETAB         Cross-term dependence of evgl         -         0           PETAB         Cross-term dependence of gamma1         -         0  | Parameter | Description                       | Units | Default |
|--|-----------|-----------------------------------|-------|---------|
| PDVT2N         Cross-term dependence of dvt2w         -         0           PDVT2N         Cross-term dependence of dvtp0         -         0           PDVTP1         Cross-term dependence of dvtp1         -         0           PDVBB         Cross-term dependence of dvb         -         0           PDWB         Cross-term dependence of dwb         -         0           PDWG         Cross-term dependence of dwg         -         0           PEMB         Cross-term dependence of egidl         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PEGISL         Cross-term dependence of egidl         -         0           PETAD         Cross-term dependence of etal         -         0           PETAD         Cross-term dependence of tab         -         0           PETAD         Cross-term dependence of gammal         -         0           PETAD         Work Function of gate         -         4.05   | PDVT1     | Cross-term dependence of dvt1     | _     | 0       |
| PDVT2W         Cross-term dependence of dvt2W         -         0           PDVTP0         Cross-term dependence of dvtp0         -         0           PDVTP1         Cross-term dependence of dvtp1         -         0           PDWB         Cross-term dependence of dwb         -         0           PEWB         Cross-term dependence of dwb         -         0           PEWGISL         Cross-term dependence of egidl         -         0           PEGISL         Cross-term dependence of egidl         -         0           PEIGBINV         Cross-term dependence of eigibnv         -         0           PETA0         Cross-term dependence of eta0         -         0           PETAB         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of pdiblob         -         0           PETROUT         Cross-term dependence of gammal         -         0           PEFRROUT         Cross-term dependence of gammal         -         0           PEGAMMA2         Cross-term dependence of gammal         -         0           PEGAMMA2         Cross-term dependence of kl         -         0           PK1         Cross-term dependence of kl         -         0 <td>PDVT1W</td> <td>Cross-term dependence of dvt1w</td> <td>-</td> <td>0</td> | PDVT1W    | Cross-term dependence of dvt1w    | -     | 0       |
| PDVTP0         Cross-term dependence of dvtp1         -         0           PDVTP1         Cross-term dependence of dvtp1         -         0           PDWB         Cross-term dependence of dwb         -         0           DWG         Cross-term dependence of dwg         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PEGISL         Cross-term dependence of egidl         -         0           PEGISL         Cross-term dependence for eighl         -         0           PETA0         Cross-term dependence of eta0         -         0           PETA0         Cross-term dependence of gamma1         -         0           PETA0         Cross-term dependence of gamma2         -         0           PETA1         Cross-term dependence of k1         -         0  | PDVT2     | Cross-term dependence of dvt2     | _     | 0       |
| PDVTP1         Cross-term dependence of dvtp1         -         0           PDWB         Cross-term dependence of dwb         -         0           PDWG         Cross-term dependence of dwg         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PETAB         Cross-term dependence of etab         -         0           PETAO         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of gammal         -         0           PERAMAL         Cross-term dependence of gammal         -         0           PK1         Cross-term dependence of k1         -         0           <  | PDVT2W    | Cross-term dependence of dvt2w    | _     | 0       |
| PDWB         Cross-term dependence of dwb         -         0           PDWG         Cross-term dependence of dwg         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PEGISI.         Cross-term dependence of egidl         -         0           PETAB.         Cross-term dependence of re eighiny         -         0           PETAB         Cross-term dependence of eta0         -         0           PETAB         Cross-term dependence of pdiblob         -         0           PETAB         Cross-term dependence of gamma1         -         0           PEGAMMA1         Cross-term dependence of gamma2         -         0           PEGAMMA2         Cross-term dependence of k1         -         0           PK1         Cross-term dependence of k2         -         0 <td>PDVTP0</td> <td>Cross-term dependence of dvtp0</td> <td>-</td> <td>0</td>           | PDVTP0    | Cross-term dependence of dvtp0    | -     | 0       |
| PDWG         Cross-term dependence of dwg         -         0           PEGIDL         Cross-term dependence of egidl         -         0           PEGISL         Cross-term dependence of egisl         -         0           PEIGBINV         Cross-term dependence of eighinv         -         0           PETA0         Cross-term dependence of eta0         -         0           PETAB         Cross-term dependence of etab         -         0           PETAB         Cross-term dependence of publich         -         0           PETAB         Cross-term dependence of gammal         -         0           PETAB         Cross-term dependence of gammal         -         0           PETAG         Work Function of gate         -         0           PEX         Cross-term dependence of k1         -         0   | PDVTP1    | Cross-term dependence of dvtp1    | _     | 0       |
| PEGIDL         Cross-term dependence of egidl         -         0           PEGISL         Cross-term dependence of egisl         -         0           PEIGBINV         Cross-term dependence for eigbinv         -         0           PETA0         Cross-term dependence of eta0         -         0           PETAB         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of eu         -         0           PEPROUT         Cross-term dependence of palibleb         -         0           PGAMMA1         Cross-term dependence of gamma1         -         0           PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK3         Cross-term dependence of k2we         -         0           PK3B         Cross-term dependence of k3b         -         0           PK53B         Cross-term dependence of k1a         -         0           PK71         Cross-term dependence of k11         -         0  | PDWB      | Cross-term dependence of dwb      | _     | 0       |
| PEGISL         Cross-term dependence of egisl         -         0           PEIGBINV         Cross-term dependence for eigbinv         -         0           PETAO         Cross-term dependence of eta0         -         0           PETAB         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of eu         -         0           PFFROUT         Cross-term dependence of pdibleb         -         0           PGAMMA1         Cross-term dependence of gamma1         -         0           PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK53B         Cross-term dependence of k6a         -         0           PKT1         Cross-term dependence of k1         -         0           PKT1         Cross-term dependence of k1         -         0 <t< td=""><td>PDWG</td><td>Cross-term dependence of dwg</td><td>_</td><td>0</td></t<>                         | PDWG      | Cross-term dependence of dwg      | _     | 0       |
| PEIGBINV         Cross-term dependence for eigbinv         -         0           PETAO         Cross-term dependence of eta0         -         0           PETAB         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of eu         -         0           PFPROUT         Cross-term dependence of pdibleb         -         0           PFPROUT         Cross-term dependence of gamma1         -         0           PGAMMA1         Cross-term dependence of gamma2         -         0           PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2         Cross-term dependence of k2         -         0           PK3         Cross-term dependence of k3         -         0           PK53B         Cross-term dependence of k43         -         0           PK51L         Cross-term dependence of k11         -         0           PKT1         Cross-term dependence of k11         -         0           <  | PEGIDL    | Cross-term dependence of egidl    | _     | 0       |
| PETAO         Cross-term dependence of eta0         -         0           PEU         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of eu         -         0           PFPROUT         Cross-term dependence of pdibleb         -         0           PFPROUT         Cross-term dependence of gammal         -         0           PGAMMA1         Cross-term dependence of gammal         -         0           PGAMMA2         Cross-term dependence of gammal         -         0           PKI         Cross-term dependence of k1         -         0           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3B         Cross-term dependence of k3         -         0           PK53B         Cross-term dependence of k6ab         -         0           PK511         Cross-term dependence of k11         -         0           PKT11         Cross-term dependence of k11         -         0           PKT2         Cross-term dependence of k12         -         0 <td< td=""><td>PEGISL</td><td>Cross-term dependence of egisl</td><td>-</td><td>0</td></td<>                    | PEGISL    | Cross-term dependence of egisl    | -     | 0       |
| PETAB         Cross-term dependence of etab         -         0           PEU         Cross-term dependence of eu         -         0           PFFROUT         Cross-term dependence of pdibleb         -         0           PFROUT         Cross-term dependence of gammal         -         0           PGAMMA1         Cross-term dependence of gammal         -         0           PGAMMA2         Cross-term dependence of gammal         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2         -         0           PK3         Cross-term dependence of k2         -         0           PK3         Cross-term dependence of k3         -         0           PK53         Cross-term dependence of k43         -         0           PK54         Cross-term dependence of kt1         -         0           PK11         Cross-term dependence of kt1         -         0           PK12         Cross-term dependence of k11         -         0           PK12   | PEIGBINV  | Cross-term dependence for eigbinv | _     | 0       |
| PEU         Cross-term dependence of eu         -         0           PFPROUT         Cross-term dependence of pdibleb         -         0           PGAMMA1         Cross-term dependence of gamma1         -         0           PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k43         -         0           PK51         Cross-term dependence of k43         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt1         -         0           PKU0         Cross-term dependence of ku0         -         0           PKV10         Cross-term dependence of ku0         -         0           PKV7HOWE   | PETA0     | Cross-term dependence of eta0     | -     | 0       |
| PFFROUT         Cross-term dependence of pdiblob         -         0           PGAMMA1         Cross-term dependence of gamma1         -         0           PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK3WE         Cross-term dependence of k3we         -         0           PK3B         Cross-term dependence of k3b         -         0           PK53B         Cross-term dependence of k4a         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt1         -         0           PKU0         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of kt0         -         0           PKU0WE         Cross-term dependence of ku0         -         0           PKVTHOWE         Cross-term dependence of kvth0         -         0           P  | PETAB     | Cross-term dependence of etab     | _     | 0       |
| PGAMMA1         Cross-term dependence of gamma1         -         0           PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0         -         0           PKVTHOWE         Cross-term dependence of kvth0         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMEDA         Cross-term dependence of lambda         -         0           <  | PEU       | Cross-term dependence of eu       | -     | 0       |
| PGAMMA2         Cross-term dependence of gamma2         -         0           PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt1         -         0           PKU0         Cross-term dependence of k1         -         0           PKU0         Cross-term dependence of k1         -         0           PKU0         Cross-term dependence of k2         -         0           PKU0         Cross-term dependence of k0         -         0           PKV1H0         Cross-term dependence of ku0we         -         0           PKVTH0WE         Cross-term dependence of kvth0         -         0           PLAMBDA  | PFPROUT   | Cross-term dependence of pdiblcb  | _     | 0       |
| PHIG         Work Function of gate         -         4.05           PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt1         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTHO         Cross-term dependence of kvth0         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lpe0         -         0           PLPEO         Cross-term dependence of lpe0         -         0  | PGAMMA1   | Cross-term dependence of gamma1   | _     | 0       |
| PK1         Cross-term dependence of k1         -         0           PK2         Cross-term dependence of k2         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKV1H0         Cross-term dependence of kv10we         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lpe0         -         0           PLPE0         Cross-term dependence of lpe0         -         0   | PGAMMA2   | Cross-term dependence of gamma2   | -     | 0       |
| PK2         Cross-term dependence of k2 we         -         0           PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTHO         Cross-term dependence of kv10we         -         0           PKVTHOWE         Cross-term dependence of kv4h0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lpe0         -         0           PLPE0         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpe0         -         0  | PHIG      | Work Function of gate             | _     | 4.05    |
| PK2WE         Cross-term dependence of k2we         -         0           PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1L         Cross-term dependence of kt1         -         0           PKU2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTH0         Cross-term dependence of kvth0         -         0           PKVTH0WE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lpe0         -         0           PLPE0         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpeb         -         0   | PK1       | Cross-term dependence of k1       | -     | 0       |
| PK3         Cross-term dependence of k3         -         0           PK3B         Cross-term dependence of k3b         -         0           PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT2L         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTHO         Cross-term dependence of kvth0         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lpe0         -         0           PLPEO         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpe0         -         0   | PK2       | Cross-term dependence of k2       | _     | 0       |
| PK3B         Cross-term dependence of k3b         -         0           PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1L         Cross-term dependence of kt11         -         0           PKU2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTHO         Cross-term dependence of kvth0         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lp         -         0           PLPE0         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpe0         -         0  | PK2WE     | Cross-term dependence of k2we     | -     | 0       |
| PKETA         Cross-term dependence of keta         -         0           PKT1         Cross-term dependence of kt1         -         0           PKT1L         Cross-term dependence of kt1l         -         0           PKT2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTHO         Cross-term dependence of kvth0         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lpe         -         0           PLPEO         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpeb         -         0   | PK3       | Cross-term dependence of k3       | _     | 0       |
| PKT1         Cross-term dependence of kt1         -         0           PKT1L         Cross-term dependence of kt1l         -         0           PKT2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTHO         Cross-term dependence of kvth0         -         0           PKVTHOWE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lp         -         0           PLPE0         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpeb         -         0  | РКЗВ      | Cross-term dependence of k3b      | _     | 0       |
| PKT1L Cross-term dependence of kt1l - 0  PKT2 Cross-term dependence of kt2 - 0  PKU0 Cross-term dependence of ku0 - 0  PKU0WE Cross-term dependence of ku0we - 0  PKVTHO Cross-term dependence of kvth0 - 0  PKVTHOWE Cross-term dependence of kvth0we - 0  PLAMBDA Cross-term dependence of lambda - 0  PLP Cross-term dependence of lp - 0  PLPE0 Cross-term dependence of lpe0 - 0  PLPEB Cross-term dependence of lpeb - 0   | PKETA     | Cross-term dependence of keta     | _     | 0       |
| PKT2         Cross-term dependence of kt2         -         0           PKU0         Cross-term dependence of ku0         -         0           PKU0WE         Cross-term dependence of ku0we         -         0           PKVTH0         Cross-term dependence of kvth0         -         0           PKVTH0WE         Cross-term dependence of kvth0we         -         0           PLAMBDA         Cross-term dependence of lambda         -         0           PLP         Cross-term dependence of lp         -         0           PLPE0         Cross-term dependence of lpe0         -         0           PLPEB         Cross-term dependence of lpeb         -         0  | PKT1      | Cross-term dependence of kt1      | _     | 0       |
| PKU0 Cross-term dependence of ku0 - 0  PKU0WE Cross-term dependence of ku0we - 0  PKVTHO Cross-term dependence of kvthO - 0  PKVTHOWE Cross-term dependence of kvthOwe - 0  PLAMBDA Cross-term dependence of lambda - 0  PLP Cross-term dependence of lpe - 0  PLPEO Cross-term dependence of lpeO - 0  PLPEB Cross-term dependence of lpeO - 0  | PKT1L     | Cross-term dependence of kt11     | _     | 0       |
| PKUOWE Cross-term dependence of ku0we - 0  PKVTHO Cross-term dependence of kvthO - 0  PKVTHOWE Cross-term dependence of kvthOwe - 0  PLAMBDA Cross-term dependence of lambda - 0  PLP Cross-term dependence of lp - 0  PLPEO Cross-term dependence of lpeO - 0  PLPEB Cross-term dependence of lpeO - 0  | PKT2      | Cross-term dependence of kt2      | _     | 0       |
| PKVTHO Cross-term dependence of kvthO - 0  PKVTHOWE Cross-term dependence of kvthOwe - 0  PLAMBDA Cross-term dependence of lambda - 0  PLP Cross-term dependence of lp - 0  PLPEO Cross-term dependence of lpeO - 0  PLPEB Cross-term dependence of lpeO - 0   | PKU0      | Cross-term dependence of ku0      | _     | 0       |
| PKVTHOWE Cross-term dependence of kvthOwe - 0  PLAMBDA Cross-term dependence of lambda - 0  PLP Cross-term dependence of lp - 0  PLPEO Cross-term dependence of lpeO - 0  PLPEB Cross-term dependence of lpeO - 0  | PKU0WE    | Cross-term dependence of ku0we    | _     | 0       |
| PLAMBDA       Cross-term dependence of lambda       -       0         PLP       Cross-term dependence of lp       -       0         PLPE0       Cross-term dependence of lpe0       -       0         PLPEB       Cross-term dependence of lpeb       -       0  | PKVTH0    | Cross-term dependence of kvth0    | _     | 0       |
| PLP Cross-term dependence of lp - 0  PLPE0 Cross-term dependence of lpe0 - 0  PLPEB Cross-term dependence of lpeb - 0  | PKVTH0WE  | Cross-term dependence of kvth0we  | _     | 0       |
| PLPE0 Cross-term dependence of lpe0 - 0 PLPEB Cross-term dependence of lpeb - 0  | PLAMBDA   | Cross-term dependence of lambda   | -     | 0       |
| PLPEB Cross-term dependence of lpeb – 0  | PLP       | Cross-term dependence of lp       | -     | 0       |
| • • •  | PLPE0     | Cross-term dependence of lpe0     | _     | 0       |
| PMINV Cross-term dependence of minv – 0  | PLPEB     | Cross-term dependence of lpeb     | _     | 0       |
|  | PMINV     | Cross-term dependence of minv     | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| PMINVCV  PMOIN  PNDEP  PNFACTOR  PNGATE  PNIGBACC  PNIGBINV | Cross-term dependence of minvev  Cross-term dependence of moin  Cross-term dependence of ndep  Cross-term dependence of nfactor  Cross-term dependence of ngate  Cross-term dependence of nigbacc | -<br>-<br>-<br>- | 0<br>0<br>0 |
|---|---|------------------|-------------|
| PNDEP PNFACTOR PNGATE PNIGBACC                              | Cross-term dependence of ndep Cross-term dependence of nfactor Cross-term dependence of ngate Cross-term dependence of nigbacc  | -<br>-<br>-      | 0           |
| PNFACTOR PNGATE PNIGBACC                                    | Cross-term dependence of nfactor  Cross-term dependence of ngate  Cross-term dependence of nigbacc  |                  |             |
| PNGATE PNIGBACC   | Cross-term dependence of nigbacc  | -                | 0           |
| PNIGBACC  | Cross-term dependence of nigbacc  | _                |             |
|   |   |                  | 0           |
| PNIGBINV  |   | _                | 0           |
| -   | Cross-term dependence of nigbinv  | _                | 0           |
| PNIGC   | Cross-term dependence of nigc   | _                | 0           |
| PNOFF   | Cross-term dependence of noff   | _                | 0           |
| PNSD  | Cross-term dependence of nsd  | -                | 0           |
| PNSUB   | Cross-term dependence of nsub   | _                | 0           |
| PNTOX   | Cross-term dependence of ntox   | _                | 0           |
| PPCLM   | Cross-term dependence of pclm   | _                | 0           |
| PPDIBLC1  | Cross-term dependence of pdiblc1  | _                | 0           |
| PPDIBLC2  | Cross-term dependence of pdiblc2  | _                | 0           |
| PPDIBLCB  | Cross-term dependence of pdiblcb  | _                | 0           |
| PPDITS  | Cross-term dependence of pdits  | _                | 0           |
| PPDITSD   | Cross-term dependence of pditsd   | _                | 0           |
| PPHIN   | Cross-term dependence of phin   | _                | 0           |
| PPIGCD  | Cross-term dependence for pigcd   | _                | 0           |
| PPOXEDGE  | Cross-term dependence for poxedge   | _                | 0           |
| PPRT  | Cross-term dependence of prt  | _                | 0           |
| PPRWB   | Cross-term dependence of prwb   | _                | 0           |
| PPRWG   | Cross-term dependence of prwg   | _                | 0           |
| PPSCBE1   | Cross-term dependence of pscbe1   | _                | 0           |
| PPSCBE2   | Cross-term dependence of pscbe2   | _                | 0           |
| PPVAG   | Cross-term dependence of pvag   | _                | 0           |
| PRDSW   | Cross-term dependence of rdsw   | _                | 0           |
| PRDW  | Cross-term dependence of rdw  | _                | 0           |
| PRSW  | Cross-term dependence of rsw  | _                | 0           |
| PRT   | Temperature coefficient of parasitic resistance   | _                | 0           |
| PTVFBSDOFF  | Cross-term dependence of tvfbsdoff  | _                | 0           |
| PTVOFF  | Cross-term dependence of tvoff  | _                | 0           |
| PU0   | Cross-term dependence of u0   | _                | 0           |
| PUA   | Cross-term dependence of ua   | _                | 0           |
| PUA1  | Cross-term dependence of ua1  | _                | 0           |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description                                    | Units | Default |
|-----------|--|-------|---------|
| PUB       | Cross-term dependence of ub                    | _     | 0       |
| PUB1      | Cross-term dependence of ub1                   | _     | 0       |
| PUC       | Cross-term dependence of uc                    | _     | 0       |
| PUC1      | Cross-term dependence of uc1                   | _     | 0       |
| PUD       | Cross-term dependence of ud                    | -     | 0       |
| PUD1      | Cross-term dependence of ud1                   | _     | 0       |
| PUP       | Cross-term dependence of up                    | -     | 0       |
| PUTE      | Cross-term dependence of ute                   | -     | 0       |
| PVAG      | Gate dependence of output resistance parameter | -     | 0       |
| PVBM      | Cross-term dependence of vbm                   | -     | 0       |
| PVBX      | Cross-term dependence of vbx                   | -     | 0       |
| PVFB      | Cross-term dependence of vfb                   | -     | 0       |
| PVFBCV    | Cross-term dependence of vfbcv                 | -     | 0       |
| PVFBSDOFF | Cross-term dependence of vfbsdoff              | -     | 0       |
| PVOFF     | Cross-term dependence of voff                  | _     | 0       |
| PVOFFCV   | Cross-term dependence of voffcv                | -     | 0       |
| PVSAT     | Cross-term dependence of vsat                  | _     | 0       |
| PVTH0     |  | -     | 0       |
| PVTL      | Cross-term dependence of vtl                   | -     | 0       |
| PW0       | Cross-term dependence of w0                    | _     | 0       |
| PWR       | Cross-term dependence of wr                    | -     | 0       |
| PXJ       | Cross-term dependence of xj                    | _     | 0       |
| PXN       | Cross-term dependence of xn                    | _     | 0       |
| PXRCRG1   | Cross-term dependence of xrcrg1                | -     | 0       |
| PXRCRG2   | Cross-term dependence of xrcrg2                | _     | 0       |
| PXT       | Cross-term dependence of xt                    | -     | 0       |
| RBDB      | Resistance between bNode and dbNode            | Ω     | 50      |
| RBDBX0    | Body resistance RBDBX scaling                  | _     | 100     |
| RBDBY0    | Body resistance RBDBY scaling                  | _     | 100     |
| RBPB      | Resistance between bNodePrime and bNode        | Ω     | 50      |
| RBPBX0    | Body resistance RBPBX scaling                  | -     | 100     |
| RBPBXL    | Body resistance RBPBX L scaling                | _     | 0       |
| RBPBXNF   | Body resistance RBPBX NF scaling               | _     | 0       |
| RBPBXW    | Body resistance RBPBX W scaling                | _     | 0       |
| RBPBY0    | Body resistance RBPBY scaling                  | _     | 100     |
| RBPBYL    | Body resistance RBPBY L scaling                | _     | 0       |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| RBPBYNF   | Body resistance RBPBY NF scaling                             | _     | 0       |
| RBPBYW    | Body resistance RBPBY W scaling                              | _     | 0       |
| RBPD      | Resistance between bNodePrime and bNode                      | Ω     | 50      |
| RBPD0     | Body resistance RBPD scaling                                 | _     | 50      |
| RBPDL     | Body resistance RBPD L scaling                               | _     | 0       |
| RBPDNF    | Body resistance RBPD NF scaling                              | _     | 0       |
| RBPDW     | Body resistance RBPD W scaling                               | _     | 0       |
| RBPS      | Resistance between bNodePrime and sbNode                     | Ω     | 50      |
| RBPS0     | Body resistance RBPS scaling                                 | _     | 50      |
| RBPSL     | Body resistance RBPS L scaling                               | _     | 0       |
| RBPSNF    | Body resistance RBPS NF scaling                              | _     | 0       |
| RBPSW     | Body resistance RBPS W scaling                               | _     | 0       |
| RBSB      | Resistance between bNode and sbNode                          | Ω     | 50      |
| RBSBX0    | Body resistance RBSBX scaling                                |       | 100     |
| RBSBY0    | Body resistance RBSBY scaling                                |       | 100     |
| RBSDBXL   | Body resistance RBSDBX L scaling                             | _     | 0       |
| RBSDBXNF  | Body resistance RBSDBX NF scaling                            | _     | 0       |
| RBSDBXW   | Body resistance RBSDBX W scaling                             | _     | 0       |
| RBSDBYL   | Body resistance RBSDBY L scaling                             | _     | 0       |
| RBSDBYNF  | Body resistance RBSDBY NF scaling                            | _     | 0       |
| RBSDBYW   | Body resistance RBSDBY W scaling                             | _     | 0       |
| RNOIA     | Thermal noise coefficient                                    | _     | 0.577   |
| RNOIB     | Thermal noise coefficient                                    | _     | 0.5164  |
| SAREF     | Reference distance between OD edge to poly of one side       | _     | 1e-06   |
| SBREF     | Reference distance between OD edge to poly of the other side | _     | 1e-06   |
| SCREF     | Reference distance to calculate SCA,SCB and SCC              | -     | 1e-06   |
| STETA0    | eta0 shift factor related to stress effect on vth            | _     | 0       |
| STK2      | K2 shift factor related to stress effect on vth              |       | 0       |
| TCJ       | Temperature coefficient of cj                                |       | 0       |
| TCJSW     | Temperature coefficient of cjsw                              | -     | 0       |
| TCJSWG    | Temperature coefficient of cjswg                             | _     | 0       |
| TKU0      | Temperature coefficient of KU0                               |       | 0       |
| TNJTS     | Temperature coefficient for NJTS                             | _     | 0       |
| TNJTSD    | Temperature coefficient for NJTSD                            | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description   | Units | Default                |
|-----------|---|-------|------------------------|
| TNJTSSW   | Temperature coefficient for NJTSSW                                  | _     | 0                      |
| TNJTSSWD  | Temperature coefficient for NJTSSWD                                 | _     | 0                      |
| TNJTSSWG  | Temperature coefficient for NJTSSWG                                 | _     | 0                      |
| TNJTSSWGD | Temperature coefficient for NJTSSWGD                                | _     | 0                      |
| TNOIA     | Thermal noise parameter   | _     | 1.5                    |
| TNOIB     | Thermal noise parameter   | _     | 3.5                    |
| TNOM      | Parameter measurement temperature                                   | -     | Ambient<br>Temperature |
| TPB       | Temperature coefficient of pb                                       | _     | 0                      |
| TPBSW     | Temperature coefficient of pbsw                                     | _     | 0                      |
| TPBSWG    | Temperature coefficient of pbswg                                    | _     | 0                      |
| TVFBSDOFF | Temperature parameter for vfbsdoff                                  | _     | 0                      |
| TVOFF     | Temperature parameter for voff                                      | _     | 0                      |
| UA1       | Temperature coefficient of ua                                       | _     | 1e-09                  |
| UB1       | Temperature coefficient of ub                                       | _     | -1e-18                 |
| UC1       | Temperature coefficient of uc                                       | _     | 0                      |
| UD1       | Temperature coefficient of ud                                       | _     | 0                      |
| UTE       | Temperature coefficient of mobility                                 | _     | -1.5                   |
| VTSD      | Drain bottom trap-assisted voltage dependent parameter              | -     | 10                     |
| VTSS      | Source bottom trap-assisted voltage dependent parameter             | -     | 10                     |
| VTSSWD    | Drain STI sidewall trap-assisted voltage dependent parameter        | _     | 10                     |
| VTSSWGD   | Drain gate-edge sidewall trap-assisted voltage dependent parameter  | -     | 10                     |
| VTSSWGS   | Source gate-edge sidewall trap-assisted voltage dependent parameter | -     | 10                     |
| VTSSWS    | Source STI sidewall trap-assisted voltage dependent parameter       | -     | 10                     |
| WA0       | Width dependence of a0  | _     | 0                      |
| WA1       | Width dependence of a1  | _     | 0                      |
| WA2       | Width dependence of a2  | _     | 0                      |
| WACDE     | Width dependence of acde  | _     | 0                      |
| WAGIDL    | Width dependence of agidl   | _     | 0                      |
| WAGISL    | Width dependence of agisl   | _     | 0                      |
| WAGS      | Width dependence of ags   | _     | 0                      |
| WAIGBACC  | Width dependence of aigbacc   | _     | 0                      |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description                 | Units | Default |
|-----------|-----------------------------|-------|---------|
| WAIGBINV  | Width dependence of aigbinv |       | 0       |
| WAIGC     | Width dependence of aigc    | _     | 0       |
| WAIGD     | Width dependence of aigd    | _     | 0       |
| WAIGS     | Width dependence of aigs    | _     | 0       |
| WAIGSD    | Width dependence of aigsd   | _     | 0       |
| WALPHA0   | Width dependence of alpha0  | _     | 0       |
| WALPHA1   | Width dependence of alpha1  | _     | 0       |
| WAT       | Width dependence of at      | -     | 0       |
| WB0       | Width dependence of b0      | _     | 0       |
| WB1       | Width dependence of b1      | _     | 0       |
| WBETA0    | Width dependence of beta0   | -     | 0       |
| WBGIDL    | Width dependence of bgidl   | _     | 0       |
| WBGISL    | Width dependence of bgisl   | _     | 0       |
| WBIGBACC  | Width dependence of bigbacc | _     | 0       |
| WBIGBINV  | Width dependence of bigbinv | _     | 0       |
| WBIGC     | Width dependence of bigc    | _     | 0       |
| WBIGD     | Width dependence of bigd    | _     | 0       |
| WBIGS     | Width dependence of bigs    | _     | 0       |
| WBIGSD    | Width dependence of bigsd   | _     | 0       |
| WCDSC     | Width dependence of cdsc    | _     | 0       |
| WCDSCB    | Width dependence of cdscb   | _     | 0       |
| WCDSCD    | Width dependence of cdscd   | _     | 0       |
| WCF       | Width dependence of cf      | _     | 0       |
| WCGDL     | Width dependence of cgdl    | _     | 0       |
| WCGIDL    | Width dependence of cgidl   | _     | 0       |
| WCGISL    | Width dependence of cgisl   | _     | 0       |
| WCGSL     | Width dependence of cgsl    | _     | 0       |
| WCIGBACC  | Width dependence of cigbacc | _     | 0       |
| WCIGBINV  | Width dependence of cigbinv | _     | 0       |
| WCIGC     | Width dependence of cigc    | _     | 0       |
| WCIGD     | Width dependence of cigd    | _     | 0       |
| WCIGS     | Width dependence of cigs    | _     | 0       |
| WCIGSD    | Width dependence of cigsd   | _     | 0       |
| WCIT      | Width dependence of cit     | _     | 0       |
| WCKAPPAD  | Width dependence of ckappad | -     | 0       |
| WCKAPPAS  | Width dependence of ckappas | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| WICLE         Width dependence of cle         -         0           MDEUTA         Width dependence of delta         -         0           MDSUB         Width dependence of drout         -         0           MDVT0         Width dependence of dvt0         -         0           MDVT0W         Width dependence of dvt0w         -         0           MDVT1         Width dependence of dvt1         -         0           MDVT1W         Width dependence of dvt1         -         0           MDVT2         Width dependence of dvt2         -         0           MDVT2W         Width dependence of dvt2w         -         0           MDVTP0         Width dependence of dvtp0         -         0           MDVTP1         Width dependence of dvtp1         -         0           MDWB         Width dependence of dwg         -         0           MDWB         Width dependence of dwg         -         0           MDWG         Width dependence of dwg         -         0           MEB         Coefficient for SCB         -         0           MEB         Coefficient for SCC         -         0           MEGISL         Width dependence of egidl         -   | Parameter | Description                  | Units | Default |
|---|-----------|------------------------------|-------|---------|
| WIGHT   Width dependence of delta   | WCLC      | Width dependence of clc      |       | 0       |
| WDROUT         Width dependence of drout         -         0           WDSUB         Width dependence of dsub         -         0           WDVTO         Width dependence of dvt0         -         0           WDVT1W         Width dependence of dvt0w         -         0           WDVT1W         Width dependence of dvt1w         -         0           WDVT1W         Width dependence of dvt2w         -         0           WDVT2W         Width dependence of dvt2w         -         0           WDVT2W         Width dependence of dvt90         -         0           WDVTPO         Width dependence of dvt90         -         0           WDVTP1         Width dependence of dvt91         -         0           WDWB         Width dependence of dwb         -         0           WDWG         Width dependence of dwg         -         0           WEBB         Coefficient for SCB         -         0           WEGISL         Width dependence of egidl         -         0           WEGISL         Width dependence of egidl         -         0           WETAB         Width dependence of egidl         -         0           WETAB         Width dependence of egidl  | WCLE      | Width dependence of cle      | _     | 0       |
| WDSUB         Width dependence of dsub         -         0           WDVTO         Width dependence of dvt0         -         0           WDVTOW         Width dependence of dvt0w         -         0           WDVT1         Width dependence of dvt1w         -         0           WDVT2W         Width dependence of dvt2w         -         0           WDVT2W         Width dependence of dvtp0         -         0           WDVTP0         Width dependence of dvtp0         -         0           WDVTP1         Width dependence of dvtp0         -         0           WDVTP1         Width dependence of dvtp1         -         0           WDWB         Width dependence of dwb         -         0           WDWB         Width dependence of dwg         -         0           WDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEB         Coefficient for SCC         -         0           WEGISL         Width dependence of egidl         -         0           WEIGBINV         Width dependence of egidl         -         0           WEIGBINV         Width dependence of eta0         - <td>WDELTA</td> <td>Width dependence of delta</td> <td>_</td> <td>0</td> | WDELTA    | Width dependence of delta    | _     | 0       |
| WEDVTO         Width dependence of dvt0         -         0           WEDVTOW         Width dependence of dvt0w         -         0           WEDVT1         Width dependence of dvt1         -         0           WEDVT1W         Width dependence of dvt1w         -         0           WEDVT2         Width dependence of dvt2w         -         0           WEDVTPQ         Width dependence of dvt0w         -         0           WEDVTPQ         Width dependence of dvt0w         -         0           WEDVTPQ         Width dependence of dvt0         -         0           WEDVTPQ         Width dependence of dvt0         -         0           WEDVTPQ         Width dependence of dvt0         -         0           WEDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEEB         Coefficient for SCB         -         0           WEEG         Coefficient for SCC         -         0           WEEGEL         Width dependence of egidl         -         0           WEEGELL         Width dependence of egidl         -         0           WEEGELL         Width dependence of egidl  | WDROUT    | Width dependence of drout    | _     | 0       |
| MDVTOW         Width dependence of dvt0w         -         0           MDVT1         Width dependence of dvt1w         -         0           MDVT2         Width dependence of dvt2w         -         0           MDVT2W         Width dependence of dvt2w         -         0           MDVTP0         Width dependence of dvtp0         -         0           MDVTP1         Width dependence of dwtp1         -         0           MDWB         Width dependence of dwb         -         0           MDWG         Width dependence of dwg         -         0           MDWG         Width dependence of EdB         -         0           MEEB         Coefficient for SCC         -         0           MEEGSIL         Width dependence of eigil         -         0           MEEGISL         Width dependence of eigil         -         0           MEETAO         Width dependence of eta0         -   | WDSUB     | Width dependence of dsub     | _     | 0       |
| MDVT1         Width dependence of dvt1         -         0           MDVT2         Width dependence of dvt2         -         0           MDVT2         Width dependence of dvt2         -         0           MDVTP0         Width dependence of dvtp0         -         0           MDVTP1         Width dependence of dvtp1         -         0           MDWB         Width dependence of dwb         -         0           MDWG         Width dependence of dwg         -         0           MDWG         Width dependence of dwg         -         0           MEB         Coefficient for SCB         -         0           MEC         Coefficient for SCC         -         0           MEGIDL         Width dependence of egidl         -         0           MEGISL         Width dependence of egidl         -         0           MEGISL         Width dependence of egidl         -         0           METAO         Width dependence of eta0         -         0           METAB         Width dependence of eta0         -         0           METAB         Width dependence of gammal         -         0           MCAMMA1         Width dependence of gammal         -  | WDVT0     | Width dependence of dvt0     | _     | 0       |
| WDVT1W         Width dependence of dvt1w         -         0           WDVT2         Width dependence of dvt2         -         0           WDVT2W         Width dependence of dvt90         -         0           WDVTP0         Width dependence of dvtp0         -         0           WDVTP1         Width dependence of dvtp1         -         0           WDWB         Width dependence of dwb         -         0           WDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGISL         Width dependence of egidl         -         0           WEIGHINV         Width dependence of egisl         -         0           WETAO         Width dependence of eta0         -         0           WETAB         Width dependence of eta0         -         0           WETAB         Width dependence of etab         -         0           WETAB         Width dependence of gammal         -         0           WEYAB         Width dependence of gammal         -         0           WEYAB         Width dependence of k1         -  | WDVT0W    | Width dependence of dvt0w    | _     | 0       |
| WDVT2         Width dependence of dvt2w         -         0           WDVT2W         Width dependence of dvt2w         -         0           WDVTPO         Width dependence of dvtp0         -         0           WDVTP1         Width dependence of dvtp1         -         0           WDWB         Width dependence of dwb         -         0           WDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGISL         Width dependence of egidl         -         0           WETAO         Width dependence of egisl         -         0           WETAO         Width dependence of eta0         -         0           WETAE         Width dependence of eta0         -         0           WETAE         Width dependence of etab         -         0           WETAE         Width dependence of gammal         -         0           WETAE         Width dependence of gammal         -         0           WETAE         Width dependence of gammal         -         0           WETAE         Width dependence of k1         -  | WDVT1     | Width dependence of dvt1     | _     | 0       |
| WDVT2W         Width dependence of dvt2W         -         0           MDVTPO         Width dependence of dvtp0         -         0           MDVTP1         Width dependence of dvtp1         -         0           MDWB         Width dependence of dwb         -         0           MDWG         Width dependence of dwg         -         0           MEBB         Coefficient for SCB         -         0           MEC         Coefficient for SCC         -         0           MEGISL         Width dependence of egidl         -         0           WEIGBINV         Width dependence of etail         -         0           WETAO         Width dependence of etail         -         0           WETAB         Width dependence of gammal         -         0           WETAB         Width dependence of gammal         -   | WDVT1W    | Width dependence of dvt1w    | _     | 0       |
| WDVTP0         Width dependence of dvtp0         -         0           WDVTP1         Width dependence of dvtp1         -         0           WDWB         Width dependence of dwb         -         0           WDWG         Width dependence of dwg         -         0           WEBB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGISL         Width dependence of egidl         -         0           WEIGBINV         Width dependence of egisl         -         0           WETAO         Width dependence of eta0         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WFPROUT         Width dependence of gamma1         -         0           WGAMMA1         Width dependence of gamma2         -         0           WKX1         Width dependence of k1         -         0           WKX2         Width dependence of k2         -         0           WKX3         Width dependence of k3         -         0           WKX3         Width dependence of k4         -         0<  | WDVT2     | Width dependence of dvt2     | _     | 0       |
| WDVTP1         Width dependence of dvtp1         -         0           WDWB         Width dependence of dwb         -         0           WDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGIDL         Width dependence of egidl         -         0           WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence of eigbinv         -         0           WETAO         Width dependence of eta0         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of etab         -         0           WEPPROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of k1         -         0           WK1         Width dependence of k2         -         0           WK2         Width dependence of k3         -         0           WK3         Width dependence of k4a         -   | WDVT2W    | Width dependence of dvt2w    | _     | 0       |
| WDWB         Width dependence of dwb         -         0           WDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGIDL         Width dependence of egidl         -         0           WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence of eigbinv         -         0           WETAO         Width dependence of eta0         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of etab         -         0           WEPROUT         Width dependence of pdibleb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of gamma2         -         0           WK1         Width dependence of k2         -         0           WK2         Width dependence of k2we         -         0           WK3         Width dependence of k3b         -         0           WK3         Width dependence of k6a         -   | WDVTP0    | Width dependence of dvtp0    | _     | 0       |
| WDWG         Width dependence of dwg         -         0           WEB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGIDL         Width dependence of egidl         -         0           WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence of eta0         -         0           WETA0         Width dependence of eta0         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WFPROUT         Width dependence of gamma1         -         0           WGAMMA1         Width dependence of gamma2         -         0           WKA1         Width dependence of k1         -         0           WKX2         Width dependence of k2         -         0           WKX3         Width dependence of k3         -         0           WKX3         Width dependence of k4s         -         0           WKX3         Width dependence of k2         -         0           WKX4         Width dependence of k2         -         0  | WDVTP1    | Width dependence of dvtp1    | _     | 0       |
| WEB         Coefficient for SCB         -         0           WEC         Coefficient for SCC         -         0           WEGIDL         Width dependence of egidl         -         0           WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence for eigbinv         -         0           WETAO         Width dependence of etaO         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of pdiblob         -         0           WFPROUT         Width dependence of gamma1         -         0           WGAMMA1         Width dependence of gamma2         -         0           WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3B         Width dependence of k3b         -         0           WK3B         Width dependence of k6a         -         0           WK5TA         Width dependence of k11         -         0           WK5TA         Width dependence of k11         -  | WDWB      | Width dependence of dwb      | _     | 0       |
| WEC         Coefficient for SCC         -         0           WEGIDL         Width dependence of egidl         -         0           WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence of eigbinv         -         0           WETAO         Width dependence of etaO         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WFROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WKA         Width dependence of gamma2         -         0           WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k3         -         0           WK3B         Width dependence of k3         -         0           WK1A         Width dependence of k6a         -         0           WK1A         Width dependence of k6a         -         0           WK1A         Width dependence of k6a         - <td< td=""><td>WDWG</td><td>Width dependence of dwg</td><td>_</td><td>0</td></td<>     | WDWG      | Width dependence of dwg      | _     | 0       |
| WEGIDL         Width dependence of egidl         -         0           WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence for eigbinv         -         0           WETAO         Width dependence of eta0         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WEPROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of gamma2         -         0           WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK53         Width dependence of k6a         -         0           WK51         Width dependence of k6a         -         0           WK51         Width dependence of k6a         -         0           WK51         Width dependence of k6a         -  | WEB       | Coefficient for SCB          | _     | 0       |
| WEGISL         Width dependence of egisl         -         0           WEIGBINV         Width dependence for eigbinv         -         0           WETAO         Width dependence of etaO         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WFPROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WKA1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k6a         -         0           WK51         Width dependence of k6a         -   | WEC       | Coefficient for SCC          | _     | 0       |
| WEIGBINV         Width dependence for eigbinv         -         0           WETAO         Width dependence of etaO         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WEPROUT         Width dependence of pdibleb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WKA1         Width dependence of k1         -         0           WKX2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k6a         -         0           WK51         Width dependence of k6a         -         0           WKT1         Width dependence of k11         -         0           WKT1         Width dependence of k11         -         0           WKT2         Width dependence of k12         -         0  | WEGIDL    | Width dependence of egidl    | _     | 0       |
| WETAO         Width dependence of etaO         -         0           WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WFPROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of k1         -         0           WK1         Width dependence of k2         -         0           WK2         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k6a         -         0           WK5TA         Width dependence of k6a         -         0           WKT1         Width dependence of k11         -         0           WKT2         Width dependence of k11         -         0  | WEGISL    | Width dependence of egisl    | _     | 0       |
| WETAB         Width dependence of etab         -         0           WEU         Width dependence of eu         -         0           WFPROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of gamma2         -         0           WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k6ab         -         0           WKT1         Width dependence of kt1         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1         -         0           WKT2         Width dependence of kt2         -         0  | WEIGBINV  | Width dependence for eigbinv | _     | 0       |
| WEU         Width dependence of eu         -         0           WFPROUT         Width dependence of pdibleb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of gamma2         -         0           WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k6a         -         0           WKT1         Width dependence of kt1         -         0           WKT1         Width dependence of kt1         -         0           WKT1         Width dependence of kt11         -         0           WKT2         Width dependence of kt2         -         0  | WETA0     | Width dependence of eta0     | _     | 0       |
| WFPROUT         Width dependence of pdiblcb         -         0           WGAMMA1         Width dependence of gamma1         -         0           WGAMMA2         Width dependence of gamma2         -         0           WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k3b         -         0           WKTA         Width dependence of keta         -         0           WKT1         Width dependence of k11         -         0           WKT1L         Width dependence of k11         -         0           WKT2         Width dependence of k12         -         0  | WETAB     | Width dependence of etab     | _     | 0       |
| WGAMMA1         Width dependence of gamma1         —         0           WGAMMA2         Width dependence of gamma2         —         0           WK1         Width dependence of k1         —         0           WK2         Width dependence of k2         —         0           WK2WE         Width dependence of k3         —         0           WK3         Width dependence of k3b         —         0           WK3B         Width dependence of keta         —         0           WKT1         Width dependence of kt1         —         0           WKT1L         Width dependence of kt11         —         0           WKT2         Width dependence of kt2         —         0   | WEU       | Width dependence of eu       | _     | 0       |
| WGAMMA2         Width dependence of gamma2         —         0           WK1         Width dependence of k1         —         0           WK2         Width dependence of k2         —         0           WK2WE         Width dependence of k2we         —         0           WK3         Width dependence of k3         —         0           WK3B         Width dependence of k3b         —         0           WKETA         Width dependence of keta         —         0           WKT1         Width dependence of kt1         —         0           WKT1L         Width dependence of kt1l         —         0           WKT2         Width dependence of kt2         —         0   | WFPROUT   | Width dependence of pdiblcb  | _     | 0       |
| WK1         Width dependence of k1         -         0           WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k3b         -         0           WKETA         Width dependence of keta         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0  | WGAMMA1   | Width dependence of gamma1   | _     | 0       |
| WK2         Width dependence of k2         -         0           WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k3b         -         0           WKETA         Width dependence of keta         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0   | WGAMMA2   | Width dependence of gamma2   | _     | 0       |
| WK2WE         Width dependence of k2we         -         0           WK3         Width dependence of k3         -         0           WK3B         Width dependence of k3b         -         0           WKETA         Width dependence of keta         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0  | WK1       | Width dependence of k1       | _     | 0       |
| WK3         Width dependence of k3         -         0           WK3B         Width dependence of k3b         -         0           WKETA         Width dependence of keta         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0   | WK2       | Width dependence of k2       | -     | 0       |
| WK3B         Width dependence of k3b         -         0           WKETA         Width dependence of keta         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0  | WK2WE     | Width dependence of k2we     | -     | 0       |
| WKETA         Width dependence of keta         -         0           WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0   | WK3       | Width dependence of k3       |       | 0       |
| WKT1         Width dependence of kt1         -         0           WKT1L         Width dependence of kt1l         -         0           WKT2         Width dependence of kt2         -         0  | WK3B      | Width dependence of k3b      | -     | 0       |
| WKT1L Width dependence of kt1l - 0 WKT2 Width dependence of kt2 - 0   | WKETA     | Width dependence of keta     | _     | 0       |
| WKT2 Width dependence of kt2 – 0  | WKT1      | Width dependence of kt1      | _     | 0       |
|   | WKT1L     | Width dependence of kt11     | _     | 0       |
| WKU0 Width dependence of ku0 – 0  | WKT2      | Width dependence of kt2      | _     | 0       |
|   | wku0      | <u> </u>                     | _     | 0       |

Table 2-103. BSIM4 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| WKU0WE    | Width dependence of ku0we                            | _     | 0       |
| WKVTH0    | Width dependence of kvth0                            | _     | 0       |
| WKVTH0WE  | Width dependence of kvth0we                          | _     | 0       |
| WL        | Width reduction parameter                            | _     | 0       |
| WLAMBDA   | Width dependence of lambda                           | _     | 0       |
| WLC       | Width reduction parameter for CV                     | _     | 0       |
| WLN       | Width reduction parameter                            | _     | 1       |
| WLOD      | Width parameter for stress effect                    | -     | 0       |
| WLODKU0   | Width parameter for u0 LOD effect                    | _     | 0       |
| WLODVTH   | Width parameter for vth LOD effect                   | _     | 0       |
| WLP       | Width dependence of lp                               | _     | 0       |
| WLPE0     | Width dependence of lpe0                             | _     | 0       |
| WLPEB     | Width dependence of lpeb                             | _     | 0       |
| WMAX      | Maximum width for the model                          | _     | 1       |
| WMIN      | Minimum width for the model                          | _     | 0       |
| WMINV     | Width dependence of minv                             | _     | 0       |
| WMINVCV   | Width dependence of minvcv                           | _     | 0       |
| WMOIN     | Width dependence of moin                             | _     | 0       |
| WNDEP     | Width dependence of ndep                             | _     | 0       |
| WNFACTOR  | Width dependence of nfactor                          | _     | 0       |
| WNGATE    | Width dependence of ngate                            | _     | 0       |
| WNIGBACC  | Width dependence of nigbacc                          | _     | 0       |
| WNIGBINV  | Width dependence of nigbiny                          | _     | 0       |
| WNIGC     | Width dependence of nigc                             | _     | 0       |
| WNOFF     | Width dependence of noff                             | _     | 0       |
| WNSD      | Width dependence of nsd                              | _     | 0       |
| WNSUB     | Width dependence of nsub                             | _     | 0       |
| WNTOX     | Width dependence of ntox                             | _     | 0       |
| WPCLM     | Width dependence of pclm                             | _     | 0       |
| WPDIBLC1  | Width dependence of pdiblc1                          | _     | 0       |
| WPDIBLC2  | Width dependence of pdiblc2                          | _     | 0       |
| WPDIBLCB  | Width dependence of pdiblcb                          | _     | 0       |
| WPDITS    | Width dependence of pdits                            | _     | 0       |
| WPDITSD   | Width dependence of pditsd                           | _     | 0       |
| WPEMOD    | Flag for WPE model (WPEMOD=1 to activate this model) | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter  | Description                   | Units | Default |
|------------|-------------------------------|-------|---------|
| WPHIN      | Width dependence of phin      | _     | 0       |
| WPIGCD     | Width dependence for pigcd    | _     | 0       |
| WPOXEDGE   | Width dependence for poxedge  | _     | 0       |
| WPRT       | Width dependence of prt       | _     | 0       |
| WPRWB      | Width dependence of prwb      | _     | 0       |
| WPRWG      | Width dependence of prwg      | _     | 0       |
| WPSCBE1    | Width dependence of pscbe1    | _     | 0       |
| WPSCBE2    | Width dependence of pscbe2    | -     | 0       |
| WPVAG      | Width dependence of pvag      | _     | 0       |
| WRDSW      | Width dependence of rdsw      | _     | 0       |
| WRDW       | Width dependence of rdw       | -     | 0       |
| WRSW       | Width dependence of rsw       | _     | 0       |
| WTVFBSDOFF | Width dependence of tvfbsdoff | -     | 0       |
| WTVOFF     | Width dependence of tvoff     | _     | 0       |
| WU0        | Width dependence of u0        | -     | 0       |
| WUA        | Width dependence of ua        | _     | 0       |
| WUA1       | Width dependence of ua1       | _     | 0       |
| WUB        | Width dependence of ub        | _     | 0       |
| WUB1       | Width dependence of ub1       | _     | 0       |
| WUC        | Width dependence of uc        | -     | 0       |
| WUC1       | Width dependence of uc1       | _     | 0       |
| WUD        | Width dependence of ud        | -     | 0       |
| WUD1       | Width dependence of ud1       | _     | 0       |
| WUP        | Width dependence of up        | _     | 0       |
| WUTE       | Width dependence of ute       | -     | 0       |
| WVBM       | Width dependence of vbm       | _     | 0       |
| WVBX       | Width dependence of vbx       | -     | 0       |
| WVFB       | Width dependence of vfb       | _     | 0       |
| WVFBCV     | Width dependence of vfbcv     | _     | 0       |
| WVFBSDOFF  | Width dependence of vfbsdoff  | -     | 0       |
| WVOFF      | Width dependence of voff      | _     | 0       |
| WVOFFCV    | Width dependence of voffcv    | _     | 0       |
| WVSAT      | Width dependence of vsat      | _     | 0       |
| WVTH0      |                               | _     | 0       |
| WVTL       | Width dependence of vtl       | _     | 0       |
| WW         | Width reduction parameter     | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| WWO         Width dependence of w0         -         0           WMC         Width reduction parameter for CV         -         0           WML         Width reduction parameter         -         0           WML         Width reduction parameter         -         0           WMN         Width dependence of wr         -         0           WMN         Width dependence of wr         -         0           WXN         Width dependence of xregl         -         0           WXRCRGIQ         Width dependence of xregl         -         0           WXT         Width dependence of xregl         -         0           XXT         Width dependence of xregl         -         0           XXXT         Distance from gate contact center to device deg   | Parameter | Description  | Units    | Default |
|--|-----------|--|----------|---------|
| WWIL         Width reduction parameter         -         0           WWLC         Width reduction parameter for CV         -         0           WWN         Width reduction parameter         -         1           WWR         Width dependence of wr         -         0           WXT         Width dependence of xi         -         0           WXR         Width dependence of xrerg1         -         0           WXRCRGG1         Width dependence of xrerg2         -         0           WXT         Width dependence of xrerg2         -         0           XXE         Lack         -         1  | WWO       | Width dependence of w0                               | _        | 0       |
| WILC         Width reduction parameter for CV         -         0           WWN         Width reduction parameter         -         1           WWR         Width dependence of wr         -         0           WXD         Width dependence of xr         -         0           WXN         Width dependence of xr         -         0           WXRCRG1         Width dependence of xrcrg2         -         0           WXT         Width dependence of xrcrg2         -         0           XXX         L         1         1         1         1         1         1         1         1         1 </td <td>WWC</td> <td>Width reduction parameter for CV</td> <td>_</td> <td>0</td>   | WWC       | Width reduction parameter for CV                     | _        | 0       |
| wwn         Width reduction parameter         -         1           wwn         Width dependence of wr         -         0           wXJ         Width dependence of xj         -         0           wXN         Width dependence of xrerg1         -         0           wXRCRGG1         Width dependence of xrerg2         -         0           wXT         Later of the part of the pendence of yrerg2         -         0         0           xXD         Later of xrerg2         -         1         1         1         1         1  | WWL       | Width reduction parameter                            | _        | 0       |
| WWR         Width dependence of wr         -         0           WXJ         Width dependence of xj         -         0           WXN         Width dependence of xn         -         0           WXRCRG1         Width dependence of xrcrg1         -         0           WXRCRG2         Width dependence of xrcrg2         -         0           WXT         Width dependence of xt         -         0           WXG         Variation in Ldrawn         -         0           XGW         Distance from gate contact center to device edge         -         0           XJBVD         Fitting parameter for drain diode breakdown current         -         1           XJBVS         Fitting parameter for source diode breakdown current         -         1           XL         L offset for channel length due to mask/etch effect         -         0           XRCRG1         First fitting parameter the bias-dependent Rg         -         1           XTL         L offset for channel length due to mask/etch effect         -         0           XRCRG2         Second fitting parameter the bias-dependent Rg         -         1           XTID         Drainjunction current temperature exponent         -         3           XTIS <t< td=""><td>WWLC</td><td>Width reduction parameter for CV</td><td>_</td><td>0</td></t<>   | WWLC      | Width reduction parameter for CV                     | _        | 0       |
| WXJ         Width dependence of xi         -         0           WXN         Width dependence of xn         -         0           WXRCRG1         Width dependence of xrcrg1         -         0           WXT         Width dependence of xrcrg2         -         0           WXT         Width dependence of xt         -         0           XGL         Variation in Ldrawn         -         0           XGW         Distance from gate contact center to device edge         -         0           XJBVD         Fitting parameter for drain diode breakdown current         -         1           XJBVS         Fitting parameter for source diode breakdown current         -         1           XL         L offset for channel length due to mask/etch effect         -         0           XRCRG1         First fitting parameter the bias-dependent Rg         -         1           XTLD         Drainjunction current temperature exponent         -         3           XT1S         Source junction current temperature exponent         -         3           XT1S         Source junction current temperature exponent         -         3           XT1S         Source junction current temperature exponent         -         0.02           XTSD <td>WWN</td> <td>Width reduction parameter</td> <td>_</td> <td>1</td>   | WWN       | Width reduction parameter                            | _        | 1       |
| WXN         Width dependence of xr         -         0           WXRCRG1         Width dependence of xrcrg1         -         0           WXRCRG2         Width dependence of xrcrg2         -         0           WXT         Width dependence of xt         -         0           XGL         Variation in Ldrawn         -         0           XGW         Distance from gate contact center to device edge         -         0           XJBVD         Fitting parameter for drain diode breakdown current         -         1           XJBVS         Fitting parameter for source diode breakdown current         -         1           XL         L offset for channel length due to mask/etch effect         -         0           XRCRG1         First fitting parameter the bias-dependent Rg         -         1           XRCRG2         Second fitting parameter the bias-dependent Rg         -         1           XTID         Drainjunction current temperature exponent         -         3           XTIS         Source junction current temperature exponent         -         3           XTIS         Source junction current temperature exponent         -         0.02           XTISS         Power dependence of JTSSWD on temperature         -         0.02 <td>WWR</td> <td>Width dependence of wr</td> <td>_</td> <td>0</td>   | WWR       | Width dependence of wr                               | _        | 0       |
| Wirker Reg 1 Width dependence of xrcrg 2 - 0  Wirker Width dependence of xrcrg 2 - 0  XGL Variation in Ldrawn - 0  XGW Distance from gate contact center to device edge - 0  XJBVD Fitting parameter for drain diode breakdown current - 1  XJBVS Fitting parameter for source diode breakdown current - 1  XL L offset for channel length due to mask/etch effect - 0  XRCRG 1 First fitting parameter the bias-dependent Rg - 12  XRCRG 2 Second fitting parameter the bias-dependent Rg - 1  XIID Drainjunction current temperature exponent - 3  XTIS Source junction current temperature exponent - 3  XTSD Power dependence of JTSD on temperature - 0.02  XTSSW Power dependence of JTSSWD on temperature - 0.02  XTSSWG Power dependence of JTSSWD on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWS on temperature - 0.02  XTSSWG Power dependence of JTSSWS on temperature - 0.02  XTSSWG Power dependence of JTSSWS on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWS on temperature - 0.02  XTSSWG Power dependence of JTSSWS on temperature - 0.02  XTSSWG Power dependence of JTSSWS on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSWG on temperature - 0.02  XTSSWG Power dependence of JTSSW           | WXJ       | Width dependence of xj                               | _        | 0       |
| WXRCRG2       Width dependence of xt       -       0         WXT       Width dependence of xt       -       0         XGL       Variation in Ldrawn       -       0         XGW       Distance from gate contact center to device edge       -       0         XJBVD       Fitting parameter for drain diode breakdown current       -       1         XJBVS       Fitting parameter for source diode breakdown current       -       1         XL       L offset for channel length due to mask/etch effect       -       0         XRCRG1       First fitting parameter the bias-dependent Rg       -       1         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XT1D       Drainjunction current temperature exponent       -       3         XT1S       Source junction current temperature exponent       -       3         XT1S       Source junction current temperature exponent       -       0.02         XTSS       Power dependence of JTSSO on temperature       -       0.02         XTSS       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS o  | WXN       | Width dependence of xn                               | _        | 0       |
| WXT       Width dependence of xt       -       0         XGL       Variation in Ldrawn       -       0         XGW       Distance from gate contact center to device edge       -       0         XJBVD       Fitting parameter for drain diode breakdown current       -       1         XJBVS       Fitting parameter for source diode breakdown current       -       1         XL       L offset for channel length due to mask/etch effect       -       0         XRCRG1       First fitting parameter the bias-dependent Rg       -       12         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       0.02         XTIS       Power dependence of JTSD on temperature       -       0.02         XTSS       Power dependence of JTSSWD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWS       Power de  | WXRCRG1   | Width dependence of xrcrg1                           | _        | 0       |
| XGL       Variation in Ldrawn       -       0         XGW       Distance from gate contact center to device edge       -       0         XJBVD       Fitting parameter for drain diode breakdown current       -       1         XJBVS       Fitting parameter for source diode breakdown current       -       1         XL       L offset for channel length due to mask/etch effect       -       0         XRCRG1       First fitting parameter the bias-dependent Rg       -       12         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       0.02         XTSS       Power dependence of JTSD on temperature       -       0.02         XTSS       Power dependence of JTSSWD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWG on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW <td>WXRCRG2</td> <td>Width dependence of xrcrg2</td> <td>_</td> <td>0</td>  | WXRCRG2   | Width dependence of xrcrg2                           | _        | 0       |
| XGW       Distance from gate contact center to device edge       -       0         XJBVD       Fitting parameter for drain diode breakdown current       -       1         XJBVS       Fitting parameter for source diode breakdown current       -       1         XL       L offset for channel length due to mask/etch effect       -       0         XRCRG1       First fitting parameter the bias-dependent Rg       -       12         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTISD       Power dependence of JTSD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWDD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0  | WXT       | Width dependence of xt                               | _        | 0       |
| XJBVD       Fitting parameter for drain diode breakdown current       -       1         XJBVS       Fitting parameter for source diode breakdown current       -       1         XL       L offset for channel length due to mask/etch effect       -       0         XRCRG1       First fitting parameter the bias-dependent Rg       -       12         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTSD       Power dependence of JTSD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         A0       Non-uniform depletion width effect coefficient       -       1     <  | XGL       | Variation in Ldrawn                                  | _        | 0       |
| XJBVS       Fitting parameter for source diode breakdown current       -       1         XL       L offset for channel length due to mask/etch effect       -       0         XRCRG1       First fitting parameter the bias-dependent Rg       -       12         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XT1D       Drainjunction current temperature exponent       -       3         XT1S       Source junction current temperature exponent       -       3         XTSD       Power dependence of JTSD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         A0       Non-uniform depletion width effect coefficient.       -       1         A1       Non-saturation effect coefficient       -       1  | XGW       | Distance from gate contact center to device edge     | _        | 0       |
| XL L offset for channel length due to mask/etch effect – 0  XRCRG1 First fitting parameter the bias-dependent Rg – 12  XRCRG2 Second fitting parameter the bias-dependent Rg – 1  XTID Drainjunction current temperature exponent – 3  XTIS Source junction current temperature exponent – 3  XTSD Power dependence of JTSD on temperature – 0.02  XTSS Power dependence of JTSS on temperature – 0.02  XTSSWD Power dependence of JTSSWD on temperature – 0.02  XTSSWD Power dependence of JTSSWD on temperature – 0.02  XTSSWGD Power dependence of JTSSWGD on temperature – 0.02  XTSSWGS Power dependence of JTSSWGS on temperature – 0.02  XTSSWGS Power dependence of JTSSWGS on temperature – 0.02  XTSSWG Power dependence of JTSSWGS on temperature – 0.02  XW W offset for channel width due to mask/etch effect – 0  Basic Parameters  A0 Non-uniform depletion width effect coefficient. – 1  A1 Non-saturation effect coefficient – 1  A2 Non-saturation effect coefficient – 1  A3 ADOS Charge centroid parameter – 1  AGS Gate bias coefficient of Abulk. V <sup>-1</sup> 0  B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0  B2 Abulk narrow width parameter m 0  B2 Abulk narrow width parameter m 0  B2 Abulk narrow width parameter m 0  B3 Abulk narrow width parameter m 0  B4 Abulk narrow width parameter m 0  B5 Abulk narrow width parameter m 0  B5 Abulk narrow width parameter m 0  B6 Abulk narrow width parameter m 0  B7 Ab | XJBVD     | Fitting parameter for drain diode breakdown current  | _        | 1       |
| XRCRG1       First fitting parameter the bias-dependent Rg       -       12         XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTSD       Power dependence of JTSD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         Basic Parameters       -       1         A0       Non-uniform depletion width effect coefficient       -       1         A1       Non-saturation effect coefficient       -       1         A2       Non-saturation effect coefficient   | XJBVS     | Fitting parameter for source diode breakdown current | _        | 1       |
| XRCRG2       Second fitting parameter the bias-dependent Rg       -       1         XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTSD       Power dependence of JTSD on temperature       -       0.02         XTSS       Power dependence of JTSSWD on temperature       -       0.02         XTSSWD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         Basic Parameters         A0       Non-uniform depletion width effect coefficient.       -       1         A1       Non-saturation effect coefficient       V-1       0         A2       Non-saturation effect coefficient       -       1         ADOS       Charge centroid parameter       -       1         AGS       Gate bias coefficient of Abulk.       V-1       0  | XL        | L offset for channel length due to mask/etch effect  | _        | 0       |
| XTID       Drainjunction current temperature exponent       -       3         XTIS       Source junction current temperature exponent       -       3         XTSD       Power dependence of JTSD on temperature       -       0.02         XTSS       Power dependence of JTSS on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGO on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         Basic Parameters         A0       Non-uniform depletion width effect coefficient       -       1         A1       Non-saturation effect coefficient       V <sup>-1</sup> 0         A2       Non-saturation effect coefficient       -       1         ADOS       Charge centroid parameter       -       1         AGS       Gate bias coefficient of Abulk.       V <sup>-1</sup> 0         B0       Abulk narrow width parameter       m       0  | XRCRG1    | First fitting parameter the bias-dependent Rg        | _        | 12      |
| XTIS       Source junction current temperature exponent       -       3         XTSD       Power dependence of JTSD on temperature       -       0.02         XTSS       Power dependence of JTSS on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWS       Power dependence of JTSSWGS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         Basic Parameters         A0       Non-uniform depletion width effect coefficient.       -       1         A1       Non-saturation effect coefficient       V-1       0         A2       Non-saturation effect coefficient       -       1         ADOS       Charge centroid parameter       -       1         AGS       Gate bias coefficient of Abulk.       V-1       0         B0       Abulk narrow width parameter       m       0         B1       Abulk narrow width parameter       m       0  | XRCRG2    | Second fitting parameter the bias-dependent Rg       | _        | 1       |
| XTSD       Power dependence of JTSD on temperature       -       0.02         XTSS       Power dependence of JTSS on temperature       -       0.02         XTSSWD       Power dependence of JTSSWD on temperature       -       0.02         XTSSWGD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         Basic Parameters         A0       Non-uniform depletion width effect coefficient.       -       1         A1       Non-saturation effect coefficient       -       1         A2       Non-saturation effect coefficient       -       1         ADOS       Charge centroid parameter       -       1         AGS       Gate bias coefficient of Abulk.       V <sup>-1</sup> 0         B0       Abulk narrow width parameter       m       0         B1       Abulk narrow width parameter       m       0   | XTID      | Drainjunction current temperature exponent           | _        | 3       |
| Power dependence of JTSS on temperature - 0.02  XTSSWD Power dependence of JTSSWD on temperature - 0.02  XTSSWGD Power dependence of JTSSWGD on temperature - 0.02  XTSSWGS Power dependence of JTSSWGS on temperature - 0.02  XTSSWS Power dependence of JTSSWGS on temperature - 0.02  XW Woffset for channel width due to mask/etch effect - 0  Basic Parameters  A0 Non-uniform depletion width effect coefficient 1  A1 Non-saturation effect coefficient V-1 0  A2 Non-saturation effect coefficient - 1  ADOS Charge centroid parameter - 1  AGS Gate bias coefficient of Abulk. V-1 0  B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0  | XTIS      | Source junction current temperature exponent         | _        | 3       |
| Power dependence of JTSSWD on temperature - 0.02  XTSSWGD Power dependence of JTSSWGD on temperature - 0.02  XTSSWGS Power dependence of JTSSWGS on temperature - 0.02  XTSSWS Power dependence of JTSSWGS on temperature - 0.02  XW Woffset for channel width due to mask/etch effect - 0  **Basic Parameters**  A0 Non-uniform depletion width effect coefficient 1  A1 Non-saturation effect coefficient V-1 0  A2 Non-saturation effect coefficient - 1  ADOS Charge centroid parameter - 1  AGS Gate bias coefficient of Abulk. V-1 0  B0 Abulk narrow width parameter m 0  Abulk narrow width parameter m 0  Abulk narrow width parameter m 0  Once where the power dependence of JTSSWGD on temperature m 0  Non-saturation effect coefficient 0  Once where the power dependence of JTSSWGD on temperature m 0  Once where the power dependence of JTSSWGD on tempe                 | XTSD      | Power dependence of JTSD on temperature              | _        | 0.02    |
| XTSSWGD       Power dependence of JTSSWGD on temperature       -       0.02         XTSSWGS       Power dependence of JTSSWGS on temperature       -       0.02         XTSSWS       Power dependence of JTSSWS on temperature       -       0.02         XW       W offset for channel width due to mask/etch effect       -       0         Basic Parameters         A0       Non-uniform depletion width effect coefficient.       -       1         A1       Non-saturation effect coefficient       V-1       0         A2       Non-saturation effect coefficient       -       1         ADOS       Charge centroid parameter       -       1         AGS       Gate bias coefficient of Abulk.       V-1       0         B0       Abulk narrow width parameter       m       0         B1       Abulk narrow width parameter       m       0   | XTSS      | Power dependence of JTSS on temperature              | -        | 0.02    |
| Power dependence of JTSSWGS on temperature - 0.02  XTSSWS Power dependence of JTSSWS on temperature - 0.02  XW Woffset for channel width due to mask/etch effect - 0  **Basic Parameters**  A0 Non-uniform depletion width effect coefficient 1  A1 Non-saturation effect coefficient V-1 0  A2 Non-saturation effect coefficient - 1  ADOS Charge centroid parameter - 1  AGS Gate bias coefficient of Abulk. V-1 0  B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0   | XTSSWD    | Power dependence of JTSSWD on temperature            | _        | 0.02    |
| XTSSWSPower dependence of JTSSWS on temperature- $0.02$ XWW offset for channel width due to mask/etch effect-0Basic ParametersA0Non-uniform depletion width effect coefficient1A1Non-saturation effect coefficient $V^{-1}$ 0A2Non-saturation effect coefficient-1ADOSCharge centroid parameter-1AGSGate bias coefficient of Abulk. $V^{-1}$ 0B0Abulk narrow width parameterm0B1Abulk narrow width parameterm0   | XTSSWGD   | Power dependence of JTSSWGD on temperature           | _        | 0.02    |
| XW       W offset for channel width due to mask/etch effect $ 0$ Basic Parameters         A0       Non-uniform depletion width effect coefficient. $ 1$ A1       Non-saturation effect coefficient $ 0$ A2       Non-saturation effect coefficient $ 1$ ADOS       Charge centroid parameter $ 1$ AGS       Gate bias coefficient of Abulk. $V^{-1}$ $0$ B0       Abulk narrow width parameter $m$ $0$ B1       Abulk narrow width parameter $m$ $0$   | XTSSWGS   | Power dependence of JTSSWGS on temperature           | _        | 0.02    |
| Basic ParametersA0Non-uniform depletion width effect coefficient. $ 1$ A1Non-saturation effect coefficient $V^{-1}$ $0$ A2Non-saturation effect coefficient $ 1$ ADOSCharge centroid parameter $ 1$ AGSGate bias coefficient of Abulk. $V^{-1}$ $0$ B0Abulk narrow width parameter $m$ $0$ B1Abulk narrow width parameter $m$ $0$  | XTSSWS    | Power dependence of JTSSWS on temperature            | -        | 0.02    |
| Non-uniform depletion width effect coefficient. $-$ 1  A1 Non-saturation effect coefficient $V^{-1}$ 0  A2 Non-saturation effect coefficient $-$ 1  ADOS Charge centroid parameter $-$ 1  AGS Gate bias coefficient of Abulk. $V^{-1}$ 0  B0 Abulk narrow width parameter $-$ m 0  B1 Abulk narrow width parameter $-$ m 0   | XW        | W offset for channel width due to mask/etch effect   | _        | 0       |
| A1 Non-saturation effect coefficient $V^{-1}$ 0  A2 Non-saturation effect coefficient $-$ 1  ADOS Charge centroid parameter $-$ 1  AGS Gate bias coefficient of Abulk. $V^{-1}$ 0  B0 Abulk narrow width parameter $  0$ B1 Abulk narrow width parameter $  0$   |           | Basic Parameters                                     |          |         |
| A2 Non-saturation effect coefficient – 1  ADOS Charge centroid parameter – 1  AGS Gate bias coefficient of Abulk. V <sup>-1</sup> 0  B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0  | AO        | Non-uniform depletion width effect coefficient.      | _        | 1       |
| ADOS Charge centroid parameter - 1  AGS Gate bias coefficient of Abulk. $V^{-1}$ 0  B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0   | A1        | Non-saturation effect coefficient                    | $V^{-1}$ | 0       |
| AGS Gate bias coefficient of Abulk. $V^{-1}$ 0  B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0   | A2        | Non-saturation effect coefficient                    | _        | 1       |
| B0 Abulk narrow width parameter m 0  B1 Abulk narrow width parameter m 0   | ADOS      | Charge centroid parameter                            | _        | 1       |
| Abulk narrow width parameter m 0   | AGS       | Gate bias coefficient of Abulk.                      | $V^{-1}$ | 0       |
| Abulk narrow width parameter m 0   | в0        | Abulk narrow width parameter                         | m        | 0       |
|  | B1        | -  | m        | 0       |
|  | BDOS      |  | _        | 1       |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description  | Units                | Default  |
|-----------|--|----------------------|----------|
| BG0SUB    | Band-gap of substrate at T=0K                                | eV                   | 1.16     |
| CDSC      | Drain/Source and channel coupling capacitance                | F/m <sup>2</sup>     | 0.00024  |
| CDSCB     | Body-bias dependence of cdsc                                 | F/(Vm <sup>2</sup> ) | 0        |
| CDSCD     | Drain-bias dependence of cdsc                                | F/(Vm <sup>2</sup> ) | 0        |
| CIT       | Interface state capacitance                                  | F/m <sup>2</sup>     | 0        |
| DELTA     | Effective Vds parameter                                      | V                    | 0.01     |
| DROUT     | DIBL coefficient of output resistance                        | _                    | 0.56     |
| DSUB      | DIBL coefficient in the subthreshold region                  | _                    | 0        |
| DVT0      | Short channel effect coeff. 0                                | _                    | 2.2      |
| DVT0W     | Narrow Width coeff. 0  | _                    | 0        |
| DVT1      | Short channel effect coeff. 1                                | _                    | 0.53     |
| DVT1W     | Narrow Width effect coeff. 1                                 | $\mathrm{m}^{-1}$    | 5.3e+06  |
| DVT2      | Short channel effect coeff. 2                                | $V^{-1}$             | -0.032   |
| DVT2W     | Narrow Width effect coeff. 2                                 | $V^{-1}$             | -0.032   |
| DVTP0     | First parameter for Vth shift due to pocket                  | m                    | 0        |
| DVTP1     | Second parameter for Vth shift due to pocket                 | $V^{-1}$             | 0        |
| DWB       | Width reduction parameter                                    | m/V <sup>1/2</sup>   | 0        |
| DWG       | Width reduction parameter                                    | m/V                  | 0        |
| EASUB     | Electron affinity of substrate                               | V                    | 4.05     |
| EPSRSUB   | Dielectric constant of substrate relative to vacuum          | _                    | 11.7     |
| ETA0      | Subthreshold region DIBL coefficient                         | _                    | 0.08     |
| ETAB      | Subthreshold region DIBL coefficient                         | $V^{-1}$             | -0.07    |
| EU        | Mobility exponent  | _                    | 0        |
| FPROUT    | Rout degradation coefficient for pocket devices              | V/m <sup>1/2</sup>   | 0        |
| K1        | Bulk effect coefficient 1                                    | $V^{-1/2}$           | 0        |
| K2        | Bulk effect coefficient 2                                    |                      | 0        |
| K3        | Narrow width effect coefficient                              | _                    | 80       |
| KETA      | Body-bias coefficient of non-uniform depletion width effect. | $V^{-1}$             | -0.047   |
| LAMBDA    | Velocity overshoot parameter                                 | -                    | 0        |
| LC        | back scattering parameter                                    | m                    | 5e-09    |
| LINT      | Length reduction parameter                                   | m                    | 0        |
| LP        | Channel length exponential factor of mobility                | m                    | 1e-08    |
| LPE0      | Equivalent length of pocket region at zero bias              | m                    | 1.74e-07 |
| LPEB      | Equivalent length of pocket region accounting for body bias  | m                    | 0        |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description  | Units              | Default  |
|-----------|--|--------------------|----------|
| MINV      | Fitting parameter for moderate inversion in Vgsteff                          | _                  | 0        |
| NFACTOR   | Subthreshold swing Coefficient   | _                  | 1        |
| NI0SUB    | Intrinsic carrier concentration of substrate at 300.15K                      | $\mathrm{cm}^{-3}$ | 1.45e+10 |
| PCLM      | Channel length modulation Coefficient  | _                  | 1.3      |
| PDIBLC1   | Drain-induced barrier lowering coefficient                                   | _                  | 0.39     |
| PDIBLC2   | Drain-induced barrier lowering coefficient                                   | _                  | 0.0086   |
| PDIBLCB   | Body-effect on drain-induced barrier lowering                                | $V^{-1}$           | 0        |
| PDITS     | Coefficient for drain-induced Vth shifts                                     | $V^{-1}$           | 0        |
| PDITSD    | Vds dependence of drain-induced Vth shifts                                   | $V^{-1}$           | 0        |
| PDITSL    | Length dependence of drain-induced Vth shifts                                | $\mathrm{m}^{-1}$  | 0        |
| PHIN      | Adjusting parameter for surface potential due to non-uniform vertical doping | V                  | 0        |
| PSCBE1    | Substrate current body-effect coefficient                                    | V/m                | 4.24e+08 |
| PSCBE2    | Substrate current body-effect coefficient                                    | m/V                | 1e-05    |
| TBGASUB   | First parameter of band-gap change due to temperature                        | eV/K               | 0.000702 |
| TBGBSUB   | Second parameter of band-gap change due to temperature                       | K                  | 1108     |
| U0        | Low-field mobility at Tnom   | $m^2/(Vs)$         | 0        |
| UA        | Linear gate dependence of mobility   | m/V                | 0        |
| UB        | Quadratic gate dependence of mobility  | $m^2/V^2$          | 1e-19    |
| UC        | Body-bias dependence of mobility   | $V^{-1}$           | 0        |
| UD        | Coulomb scattering factor of mobility  | $\mathrm{m}^{-2}$  | 0        |
| UP        | Channel length linear factor of mobility                                     | $\mathrm{m}^{-2}$  | 0        |
| VBM       | Maximum body voltage   | V                  | -3       |
| VDDEOT    | Voltage for extraction of equivalent gate oxide thickness                    | V                  | 1.5      |
| VFB       | Flat Band Voltage  | V                  | -1       |
| VOFF      | Threshold voltage offset   | V                  | -0.08    |
| VOFFL     | Length dependence parameter for Vth offset                                   | V                  | 0        |
| VSAT      | Saturation velocity at tnom  | m/s                | 80000    |
| VTH0      |  | V                  | 0        |
| VTL       | thermal velocity   | m/s                | 200000   |
| W O       | Narrow width effect parameter  | m                  | 2.5e-06  |
|           | Width reduction parameter  | m                  | 0        |
| WINT      |  |                    |          |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| ACDE        | Exponential coefficient for finite charge thickness         | m/V   | 1       |
| CF          | Fringe capacitance parameter                                | F/m   | 0       |
| CGBO        | Gate-bulk overlap capacitance per length                    | _     | 0       |
| CGDL        | New C-V model parameter                                     | F/m   | 0       |
| CGDO        | Gate-drain overlap capacitance per width                    | F/m   | 0       |
| CGSL        | New C-V model parameter                                     | F/m   | 0       |
| CGSO        | Gate-source overlap capacitance per width                   | F/m   | 0       |
| CKAPPAD     | D/G overlap C-V parameter                                   | V     | 0.6     |
| CKAPPAS     | S/G overlap C-V parameter                                   | V     | 0.6     |
| CLC         | Vdsat parameter for C-V model                               | m     | 1e-07   |
| CLE         | Vdsat parameter for C-V model                               | _     | 0.6     |
| DLC         | Delta L for C-V model                                       | m     | 0       |
| DWC         | Delta W for C-V model                                       | m     | 0       |
| MINVCV      | Fitting parameter for moderate inversion in Vgsteffcv       | _     | 0       |
| MOIN        | Coefficient for gate-bias dependent surface potential       | _     | 15      |
| NOFF        | C-V turn-on/off parameter                                   | _     | 1       |
| VFBCV       | Flat Band Voltage parameter for capmod=0 only               | V     | -1      |
| VOFFCV      | C-V lateral-shift parameter                                 | V     | 0       |
| VOFFCVL     | Length dependence parameter for Vth offset in CV            | _     | 0       |
| XPART       | Channel charge partitioning                                 | F/m   | 0       |
|             | Control Parameters  |       |         |
| ACNQSMOD    | AC NQS model selector                                       | _     | 0       |
| BINUNIT     | Bin unit selector   | _     | 1       |
| CAPMOD      | Capacitance model selector                                  | _     | 2       |
| CVCHARGEMOD | Capacitance charge model selector                           | _     | 0       |
| DIOMOD      | Diode IV model selector                                     | _     | 1       |
| FNOIMOD     | Flicker noise model selector                                | _     | 1       |
| GEOMOD      | Geometry dependent parasitics model selector                | _     | 0       |
| IGBMOD      | Gate-to-body Ig model selector                              | _     | 0       |
| IGCMOD      | Gate-to-channel Ig model selector                           | _     | 0       |
| MOBMOD      | Mobility model selector                                     | _     | 0       |
| MTRLMOD     | parameter for nonm-silicon substrate or metal gate selector | _     | 0       |
| PARAMCHK    | Model parameter checking selector                           | _     | 1       |
| PERMOD      | Pd and Ps model selector                                    | _     | 1       |
| RBODYMOD    | Distributed body R model selector                           | _     | 0       |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description  | Units                        | Default               |
|-----------|--|------------------------------|-----------------------|
| RDSMOD    | Bias-dependent S/D resistance model selector             | _                            | 0                     |
| RGATEMOD  | Gate R model selector                                    | _                            | 0                     |
| TEMPMOD   | Temperature model selector                               | _                            | 0                     |
| TNOIMOD   | Thermal noise model selector                             | _                            | 0                     |
| TRNQSMOD  | Transient NQS model selector                             | _                            | 0                     |
| VERSION   | parameter for model version                              | _                            | '4.6.1'               |
|           | Flicker and Thermal Noise Parameters                     |                              |                       |
| NOIA      | Flicker Noise parameter a                                | _                            | 0                     |
| NOIB      | Flicker Noise parameter b                                | _                            | 0                     |
| NOIC      | Flicker Noise parameter c                                | _                            | 0                     |
|           | Process Parameters                                       |                              |                       |
| DTOX      | Defined as (toxe - toxp)                                 | m                            | 0                     |
| EOT       | Equivalent gate oxide thickness in meters                | m                            | 1.5e-09               |
| EPSROX    | Dielectric constant of the gate oxide relative to vacuum | -                            | 3.9                   |
| GAMMA1    | Vth body coefficient                                     | $V^{1/2}$                    | 0                     |
| GAMMA2    | Vth body coefficient                                     | $V^{1/2}$                    | 0                     |
| NDEP      | Channel doping concentration at the depletion edge       | $\mathrm{cm}^{-3}$           | 1.7e+17               |
| NGATE     | Poly-gate doping concentration                           | $\mathrm{cm}^{-3}$           | 0                     |
| NSD       | S/D doping concentration                                 | $\mathrm{cm}^{-3}$           | 1e+20                 |
| NSUB      | Substrate doping concentration                           | $\mathrm{cm}^{-3}$           | 6e+16                 |
| RSH       | Source-drain sheet resistance                            | $\Omega/\square$             | 0                     |
| RSHG      | Gate sheet resistance                                    | $\Omega/\Box$                | 0.1                   |
| TOXE      | Electrical gate oxide thickness in meters                | m                            | 3e-09                 |
| TOXM      | Gate oxide thickness at which parameters are extracted   | m                            | 3e-09                 |
| TOXP      | Physical gate oxide thickness in meters                  | m                            | 3e-09                 |
| VBX       | Vth transition body Voltage                              | V                            | 0                     |
| XJ        | Junction depth in meters                                 | m                            | 1.5e-07               |
| XT        | Doping depth   | m                            | 1.55e-07              |
|           | Tunnelling Parameters                                    |                              |                       |
| AIGBACC   | Parameter for Igb  | $(Fs^2/g)^{1/2}/m0.0136$     |                       |
| AIGBINV   | Parameter for Igb  | $(Fs^2/g)^{1/2}/m0.0111$     |                       |
| AIGC      | Parameter for Igc  | $(Fs^2/g)^{1/2}$             | <sup>2</sup> /m0.0136 |
| AIGD      | Parameter for Igd  | $(Fs^2/g)^{1/2}/m0.0136$     |                       |
| AIGS      | Parameter for Igs  | $(\text{Fs}^2/\sigma)^{1/2}$ | <sup>2</sup> /m0.0136 |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description                                       | Units            | Default                         |
|-----------|---|------------------|---------------------------------|
| BIGBACC   | Parameter for Igb                                 | $(Fs^2/g)^{1/2}$ | <sup>2</sup> /m <b>W</b> 00171  |
| BIGBINV   | Parameter for Igb                                 | $(Fs^2/g)^{1/}$  | <sup>2</sup> /m <b>W</b> 000949 |
| BIGC      | Parameter for Igc                                 | $(Fs^2/g)^{1/2}$ | <sup>2</sup> /m <b>0</b> /00171 |
| BIGD      | Parameter for Igd                                 | $(Fs^2/g)^{1/}$  | <sup>2</sup> /m <b>W</b> 00171  |
| BIGS      | Parameter for Igs                                 | $(Fs^2/g)^{1/2}$ | <sup>2</sup> /mW00171           |
| CIGBACC   | Parameter for Igb                                 | $V^{-1}$         | 0.075                           |
| CIGBINV   | Parameter for Igb                                 | $V^{-1}$         | 0.006                           |
| CIGC      | Parameter for Igc                                 | $V^{-1}$         | 0.075                           |
| CIGD      | Parameter for Igd                                 | $V^{-1}$         | 0.075                           |
| CIGS      | Parameter for Igs                                 | $V^{-1}$         | 0.075                           |
| DLCIGD    | Delta L for Ig model drain side                   | m                | 0                               |
| EIGBINV   | Parameter for the Si bandgap for Igbinv           | V                | 1.1                             |
| NIGBACC   | Parameter for Igbacc slope                        | _                | 1                               |
| NIGBINV   | Parameter for Igbinv slope                        | _                | 3                               |
| NIGC      | Parameter for Igc slope                           | -                | 1                               |
| NTOX      | Exponent for Tox ratio                            | -                | 1                               |
| PIGCD     | Parameter for Igc partition                       | _                | 1                               |
| POXEDGE   | Factor for the gate edge Tox                      | -                | 1                               |
| TOXREF    | Target tox value                                  | m                | 3e-09                           |
| VFBSDOFF  | S/D flatband voltage offset                       | V                | 0                               |
|           | Asymmetric and Bias-Dependent $R_{ds}$ Parameters |                  |                                 |
| PRWB      | Body-effect on parasitic resistance               | $V^{-1}$         | 0                               |
| PRWG      | Gate-bias effect on parasitic resistance          | $V^{-1}$         | 1                               |
| RDSW      | Source-drain resistance per width                 | $\Omega \mu m$   | 200                             |
| RDSWMIN   | Source-drain resistance per width at high Vg      | Ωμm              | 0                               |
| RDW       | Drain resistance per width                        | $\Omega \mu m$   | 100                             |
| RDWMIN    | Drain resistance per width at high Vg             | Ωμm              | 0                               |
| RSW       | Source resistance per width                       | $\Omega \mu m$   | 100                             |
| RSWMIN    | Source resistance per width at high Vg            | $\Omega \mu m$   | 0                               |
| WR        | Width dependence of rds                           | _                | 1                               |
|           | Impact Ionization Current Parameters              |                  |                                 |
| ALPHA0    | substrate current model parameter                 | m/V              | 0                               |
| ALPHA1    | substrate current model parameter                 | $V^{-1}$         | 0                               |
| BETA0     | substrate current model parameter                 | $V^{-1}$         | 0                               |

**Table 2-103. BSIM4 Device Model Parameters** 

| Parameter | Description                                | Units         | Default |
|-----------|--|---------------|---------|
| AGIDL     | Pre-exponential constant for GIDL          | $\Omega^{-1}$ | 0       |
| AGISL     | Pre-exponential constant for GISL          | $\Omega^{-1}$ | 0       |
| BGIDL     | Exponential constant for GIDL              | V/m           | 2.3e+09 |
| BGISL     | Exponential constant for GISL              | V/m           | 2.3e-09 |
| CGIDL     | Parameter for body-bias dependence of GIDL | $V^3$         | 0.5     |
| CGISL     | Parameter for body-bias dependence of GISL | $V^3$         | 0.5     |
| EGIDL     | Fitting parameter for Bandbending          | V             | 0.8     |
| EGISL     | Fitting parameter for Bandbending          | V             | 0.8     |

## 2.3.20.8. Level 18 MOSFET Tables (VDMOS)

The vertical double-diffused power MOSFET model is based on the uniform charge control model (UCCM) developed at Rensselaer Polytechnic Institute [16]. The VDMOS current-voltage characteristics are described by a single, continuous analytical expression for all regimes of operation. The physics-based model includes effects such as velocity saturation in the channel, drain induced barrier lowering, finite output conductance in saturation, the quasi-saturation effect through a bias dependent drain parasitic resistance, effects of bulk charge, and bias dependent low-field mobility. An important feature of the implementation is the utilization of a single continuous expression for the drain current, which is valid below and above threshold, effectively removing discontinuities and improving convergence properties.

The following tables give parameters for the level 18 MOSFET.

**Table 2-104. Power MOSFET Device Instance Parameters** 

| Parameter | Description  | Units | Default                |
|-----------|--|-------|------------------------|
| AD        | Drain diffusion area                                       | $m^2$ | 0                      |
| AS        | Source diffusion area                                      | $m^2$ | 0                      |
| L         | Channel length   | m     | 0                      |
| M         | Multiplier for M devices connected in parallel             | -     | 1                      |
| NRD       | Multiplier for RSH to yield parasitic resistance of drain  |       | 1                      |
| NRS       | Multiplier for RSH to yield parasitic resistance of source |       | 1                      |
| PD        | Drain diffusion perimeter                                  | m     | 0                      |
| PS        | Source diffusion perimeter                                 | m     | 0                      |
| TEMP      | Device temperature   | °C    | Ambient<br>Temperature |
| W         | Channel width  | m     | 0                      |

Table 2-105. Power MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| AI        |  | _     | 2e+09   |
| ALPHA     | Parameter accounting for the threshold dependence on the channel potential | -     | 0       |
| ARTD      |  | _     | 0       |
| BI        |  | -     | 8e+08   |
| BRTD      |  | _     | 0.035   |
| CBD       | Zero-bias bulk-drain p-n capacitance                                       | F     | 0       |
| CBS       | Zero-bias bulk-source p-n capacitance                                      | F     | 0       |
| CGBO      | Gate-bulk overlap capacitance/channel length                               | F/m   | 0       |
| CGDO      | Gate-drain overlap capacitance/channel width                               | F/m   | 0       |

Table 2-105. Power MOSFET Device Model Parameters

| Parameter   | Description  | Units            | Default |
|-------------|--|------------------|---------|
| CGSO        | Gate-source overlap capacitance/channel width              | F/m              | 0       |
| CJ          | Bulk p-n zero-bias bottom capacitance/area                 | F/m <sup>2</sup> | 0       |
| CJSW        | Bulk p-n zero-bias sidewall capacitance/area               | F/m <sup>2</sup> | 0       |
| CRTD        |  | _                | 0.1472  |
| CV          | Charge model storage selector                              | _                | 1       |
| CVE         | Meyer-like capacitor model selector                        | _                | 1       |
| D1AF        | Drain-source diode flicker noise exponent                  | _                | 1       |
| D1BV        | Drain-source diode reverse breakdown voltage               | V                | 1e+99   |
| D1CJO       | Drain-source diode junction capacitance                    | F                | 0       |
| D1EG        | Drain-source diode activation energy                       | eV               | 1.11    |
| D1FC        | Drain-source diode forward bias depletion capacitance      | -                | 0.5     |
| D1IBV       | Drain-source diode current at breakdown voltage            | A                | 0.001   |
| D1IKF       | Drain-source diode high injection knee currrent            | A                | 0       |
| D1IS        | Drain-Source diode saturation current                      | A                | 1e-14   |
| D1ISR       | Drain-source diode recombination saturation current        | A                | 0       |
| D1KF        | Drain-source diode flicker noise coefficient               | _                | 0       |
| D1M         | Drain-source diode grading coefficient                     | _                | 0.5     |
| D1N         | Drain-source diode emission coefficient                    | _                | 1       |
| D1NR        | Drain-source diode recombination emission coefficient      | -                | 2       |
| D1RS        | Drain-source diode ohmic resistance                        | Ω                | 0       |
| D1TNOM      | Drain-source diode nominal temperature                     | °C               | 300.15  |
| D1TT        | Drain-source diode transit time                            | s                | 0       |
| D1VJ        | Drain-source diode junction potential                      | V                | 1       |
| D1XTI       | Drain-source diode sat. current temperature exponent       | _                | 3       |
| DELMAX      |  | _                | 0.9     |
| DELTA       | Transition width parameter                                 | _                | 5       |
| DRIFTPARAMA | Drift region resistance intercept parameter                | Ω                | 0.08    |
| DRIFTPARAMB | Drift region resistance slope parameter                    | $\Omega  V^{-1}$ | 0.013   |
| DRTD        |  | _                | 0.0052  |
| ETA         | Subthreshold ideality factor                               | _                | 1.32    |
| FC          | Coefficient for forward-bias depletion capacitance formula | -                | 0.5     |
| FPE         | Charge partitioning scheme selector                        | _                | 1       |
| GAMMAL0     | Body effect constant in front of linear term               | _                | 0       |
| GAMMAS0     | Body effect constant in front of square root term          | $V^{-1/2}$       | 0.5     |

Table 2-105. Power MOSFET Device Model Parameters

| Parameter | Description   | Units              | Default |
|-----------|---|--------------------|---------|
| IS        | Bulk p-n saturation current                                       | A                  | 1e-14   |
| ISUBMOD   |   | _                  | 0       |
| JS        | Bulk p-n saturation current density                               | A/m <sup>2</sup>   | 0       |
| K         |   | _                  | 0       |
| KVS       |   | _                  | 0       |
| KVT       |   | _                  | 0       |
| L0        | Gate length of nominal device                                     | m                  | 0       |
| LAMBDA    | Output conductance parameter                                      | $V^{-1}$           | 0.048   |
| LD        | Lateral diffusion length  | m                  | 0       |
| LGAMMAL   | Sensitivity of gL on device length                                | _                  | 0       |
| LGAMMAS   | Sensitivity of gS on device length                                | $V^{-1/2}$         | 0       |
| LS        |   | _                  | 3.5e-08 |
| M         | Knee shape parameter  | _                  | 4       |
| MC        |   | _                  | 3       |
| MCV       | Transition width parameter used by the charge partitioning scheme | -                  | 10      |
| MD        |   | _                  | 2       |
| MDTEMP    |   | _                  | 0       |
| MJ        | Bulk p-n bottom grading coefficient                               | _                  | 0.5     |
| MJSW      | Bulk p-n sidewall grading coefficient                             | _                  | 0.5     |
| MTH       |   | -                  | 0       |
| N2        |   | _                  | 1       |
| NRTD      |   | -                  | 0.115   |
| NSS       | Surface state density   | $\mathrm{cm}^{-2}$ | 0       |
| NSUB      | Substrate doping density  | $\mathrm{cm}^{-3}$ | 0       |
| РВ        | Bulk p-n bottom potential   | V                  | 0.8     |
| PHI       | Surface potential   | V                  | 0.6     |
| RD        | Drain ohmic resistance  | Ω                  | 0       |
| RDSSHUNT  | Drain-source shunt resistance                                     | Ω                  | 0       |
| RG        | Gate ohmic resistance   | Ω                  | 0       |
| RS        | Source ohmic resistance   | Ω                  | 0       |
| RSH       | Drain, source diffusion sheet resistance                          | Ω                  | 0       |
| RSUB      |   | _                  | 0       |
| SIGMA0    | DIBL parameter  | _                  | 0.048   |
| TEMPMODEL | Specifies the type of parameter interpolation over temperature    | _                  | 'NONE'  |

**Table 2-105. Power MOSFET Device Model Parameters** 

| Parameter | Description   | Units                      | Default                |
|-----------|---|----------------------------|------------------------|
| THETA     | Mobility degradation parameter  | m/V                        | 0                      |
| TNOM      | Nominal device temperature  | °C                         | Ambient<br>Temperature |
| TOX       | Gate oxide thickness  | m                          | 1e-07                  |
| TPG       | Gate material type (-1 = same as substrate, 0 = aluminum,1 = opposite of substrate) | _                          | 1                      |
| TS        |   | _                          | 0                      |
| TVS       |   | _                          | 0                      |
| U0        | Surface mobility  | 1/(Vcm <sup>2</sup> s) 280 |                        |
| UO        | Surface mobility  | 1/(Vcm <sup>2</sup> s)     | 280                    |
| VFB       | Flat band voltage   | V                          | 0                      |
| VMAX      | Maximum drift velocity for carriers   | m/s                        | 40000                  |
| VP        |   |                            | 0                      |
| VSIGMA    | DIBL parameter  | V                          | 0.2                    |
| VSIGMAT   | DIBL parameter  | V                          | 1.7                    |
| VTO       | Zero-bias threshold voltage   | V                          | 0                      |
| WO        | Gate width of nominal device  | m                          | 0                      |
| WGAMMAL   | Sensitivity of gL on device width   |                            | 0                      |
| WGAMMAS   | Sensitivity of gS on device width   | $V^{-1/2}$                 | 0                      |
| XJ        | Metallurgical junction depth  | m                          | 0                      |
| XQC       | Charge partitioning factor  | _                          | 0.6                    |

## 2.3.20.9. Levels 70 and 70450 MOSFET Tables (BSIM-SOI 4.6.1 and 4.5.0)

For complete documentation of the BSIM-SOI model, see the users' manual for the BSIM-SOI, available for download at http://bsim.berkeley.edu/models/bsimsoi/. Xyce implements Version 4.6.1 of the BSIM-SOI as the level 70 device and version 4.5.0 as level 70450.

Instance and model parameters of the level 70 MOSFET are given in tables 2-106 and 2-107.

Beginning with Xyce 7.2, the BSIM-SOI models level 70 and 70450 have *limited* support for the optional 5th, 6th, and 7th nodes. See the BSIM-SOI technical manual at the BSIM web site for details of what configurations the full device supports. Only some of these use cases are supported: Use of the BSIM-SOI 4.x with TNODEOUT=0 (the default) is supported in 4-, 5-, 6-, and 7-node configurations. TNODEOUT=1 is supported only in the 7-node configuration, with the 7th node being temperature. No access to the external temperature node is available in 5- or 6- node configuration.

When TNODEOUT=0, the temperature node is an internal node of the device even when not specified on the instance line, and its value may still be printed using the N() notation (see section 2.1.31.12). This somewhat minimizes the impact of the lack of support for TNODEOUT=1 in Xyce — the temperature rise due to self-heating is always available for printing, but it is not available for creation of a thermal coupling network except in the 7-node configuration.

Note that with some choices of model parameters, the BSIM-SOI devices attempt to "collapse" the "P" and "B" nodes (external and internal body nodes, 5th and 6th netlist nodes if given, internal nodes if not given). Xyce is unable to perform such collapse when the nodes are externally specified, and will issue warnings when it finds the model trying to do so. Depending on the actual nodes used for P and B, the device may fail to converge or produce invalid results; as an example, if P and B are actually specified on the netlist line to be the same node, this failure to collapse will not matter — the nodes are already the same. But if two different node names are used for the 5th and 6th nodes, the failure to collapse will leave one node floating and the simulation will likely fail if the printed warnings are ignored.

A similar problem exists for other choices of model parameter: in some cases neither the "P" nor "B" nodes are used, and if the nodes are specified on the netlist line the BSIM-SOI code attempts to collapse them to ground. This is not something Xyce can do, and therefore instead Xyce ignores the specified nodes. This can leave those nodes floating and lead to convergence failures unless the specified nodes are already the ground node (node 0). Xyce will issue appropriate warnings when this condition exists and suggest removal of the unused external nodes from the instance line.

The BSIM SOI 4.6.1 device supports output of the internal variables in table 2-108 on the .PRINT line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific level 70 M device in your netlist.

**NOTE:** It has been observed that the gate capacitance model of BSIM-SOI 4.6.1 behaves differently than earlier versions, and the team has seen significant disagreement of gate currents when comparing identical simulations with other simulators that have only earlier BSIM-SOI models. For this reason, we are also providing BSIM-SOI 4.5.0 as the level 70450 MOSFET. This model does agree with these other simulators. The parameters and output variables are given in tables 2-109, 2-110, and 2-111. Unlike BSIM-SOI 4.6.1, the 4.5.0 model's original Verilog-A source code does not contain descriptions and units for the parameters, and these appear blank in the tables. For descriptions and units, see the corresponding parameters in the level 70 tables.

Table 2-106. BSIM-SOI 4.6.1 Device Instance Parameters

| Parameter | Description   | Units          | Default |
|-----------|---|----------------|---------|
| AD        | Drain area  | $m^2$          | 0       |
| AEBCP     | Substrate to body overlap area for bc parasitics                                | m <sup>2</sup> | 0       |
| AGBCP     | Gate to body overlap area for bc parasitics                                     | m <sup>2</sup> | 0       |
| AGBCP2    | Parasitic Gate to body overlap area for bc parasitics /* v4.1 improvement on BC | m <sup>2</sup> | 0       |
| AGBCPD    | Gate to body overlap area for bc parasitics in DC                               | m <sup>2</sup> | 0       |
| AS        | Source area   | m <sup>2</sup> | 0       |
| BJTOFF    | BJT on/off flag   | _              | 0       |
| CTH0      | Instance Thermal Capacitance  | _              | 1e-05   |
| DEBUG     | DEBUG on/off flag   | _              | 0       |
| DELVTO    | Zero bias threshold voltage variation   | V              | 0       |
| DTEMP     | device temperature offset from ambient  | _              | 0       |
| FRBODY    | layout dependent body-resistance coefficient                                    |                | 1       |
| L         | Length  | m              | 5e-06   |
| M         | multiplicity factor   | _              | 1       |
| NBC       | Number of body contact isolation edge   | _              | 0       |
| NF        | Number of fingers   | _              | 1       |
| NRB       | Number of squares in body   | _              | 1       |
| NRD       | Number of squares in drain  | _              | 1       |
| NRS       | Number of squares in source   | _              | 1       |
| NSEG      | Number segments for width partitioning  | _              | 1       |
| OFF       | Device is initially off   | _              | 0       |
| PD        | Drain perimeter   | m              | 0       |
| PDBCP     | Perimeter length for bc parasitics at drain side                                | m              | 0       |
| PS        | Source perimeter  | m              | 0       |
| PSBCP     | Perimeter length for bc parasitics at source side                               | m              | 0       |
| RBDB      | Body resistance   | _              | 50      |
| RBSB      | Body resistance   | _              | 50      |
| RTH0      | Instance Thermal Resistance   | _              | 0       |
| SA        | distance between OD edge to poly of one side                                    | m              | 0       |
| SB        | distance between OD edge to poly of the other side                              | m              | 0       |
| SD        | distance between neighbor fingers   | m              | 0       |
| SHMOD     | Self heating mode selector  | _              | 0       |
| SOIMOD    | Instance model selector for PD/FD operation /* v3.2                             | _              | 0       |
| TNODEOUT  | Flag indicating external temp node  | _              | 0       |
| W         | Width   | m              | 5e-06   |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units          | Default    |
|-----------|---|----------------|------------|
| A0        | Non-uniform depletion width effect coefficient.   | _              | 1          |
| A1        | Non-saturation effect coefficient   | _              | 0          |
| A2        | Non-saturation effect coefficient   | _              | 1          |
| ABJTII    | Exponent factor for avalanche current   | _              | 0          |
| ACDE      | Exponential coefficient for charge thickness in capMod=3 for accumulation and depletion regions | m/V            | 1          |
| AD        | Drain area  | m <sup>2</sup> | 0          |
| ADOS      | Charge centroid parameter   | _              | 1          |
| AEBCP     | Substrate to body overlap area for bc parasitics  | m <sup>2</sup> | 0          |
| AELY      | Channel length dependency of early voltage for bipolar current                                  | _              | 0          |
| AF        | Flicker noise exponent  | _              | 1          |
| AGB1      | 'A' for Igb1 Tunneling current model  | _              | 3.7622e-07 |
| AGB2      | 'A' for Igb2 Tunneling current model  | _              | 4.9758e-07 |
| AGBC2N    | NMOS 'A' for tunneling current model  | _              | 3.4254e-07 |
| AGBC2P    | PMOS 'A' for tunneling current model  | _              | 4.9723e-07 |
| AGBCP     | Gate to body overlap area for bc parasitics   | $m^2$          | 0          |
| AGBCP2    | Parasitic Gate to body overlap area for bc parasitics /* v4.1 improvement on BC                 | $m^2$          | 0          |
| AGBCPD    | Gate to body overlap area for bc parasitics in DC   | m <sup>2</sup> | 0          |
| AGIDL     | GIDL second parameter   | _              | 0          |
| AGISL     | GISL second parameter   | _              | 0          |
| AGS       | Gate bias coefficient of Abulk.   | _              | 0          |
| AHLI      | High level injection parameter for bipolar current /* v4.0                                      | _              | 0          |
| AHLID     | High level injection parameter for bipolar current /* v4.0                                      | _              | 0          |
| AIGBCP2   | First Vgp dependent parameter for gate current in accumulation in AGBCP2 region                 | _              | 0.043      |
| AIGC      | Parameter for Igc   | _              | 0          |
| AIGSD     | Parameter for Igs,d   | _              | 0          |
| ALPHA0    | substrate current model parameter   | m/V            | 0          |
| ALPHAGB1  | First Vox dependent parameter for gate current in inversion                                     |                | 0.35       |
| ALPHAGB2  | First Vox dependent parameter for gate current in accumulation                                  |                | 0.43       |
| AS        | Source area   | $m^2$          | 0          |
| ASD       | Source/drain bottom diffusion smoothing parameter   |                | 0.3        |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default     |
|-----------|--|-------|-------------|
| AT        | Temperature coefficient of vsat  | _     | 33000       |
| в0        | Abulk narrow width parameter   | m     | 0           |
| B1        | Abulk narrow width parameter   | m     | 0           |
| BDOS      | Charge centroid parameter  | _     | 1           |
| BETA0     | First Vds dependent parameter of impact ionization current                       | _     | 0           |
| BETA1     | Second Vds dependent parameter of impact ionization current                      | _     | 0           |
| BETA2     | Third Vds dependent parameter of impact ionization current                       | V     | 0.1         |
| BETAGB1   | Second Vox dependent parameter for gate current in inversion                     | _     | 0.03        |
| BETAGB2   | Second Vox dependent parameter for gate current in accumulation                  | _     | 0.05        |
| BF        | Flicker noise length dependence exponent   | _     | 2           |
| BG0SUB    | Band-gap of substrate at T=0K  | _     | 1.16        |
| BGB1      | 'B' for Igb1 Tunneling current model   | _     | -3.1051e+10 |
| BGB2      | 'B' for Igb2 Tunneling current model   | _     | -2.357e+10  |
| BGBC2N    | NMOS 'B' for tunneling current model   | _     | 1.1665e+12  |
| BGBC2P    | PMOS 'B' for tunneling current model   | _     | 7.4567e+11  |
| BGIDL     | GIDL third parameter   | _     | 2.3e+09     |
| BGISL     | GISL third parameter   | _     | 0           |
| BIGBCP2   | Second Vgp dependent parameter for gate current in accumulation in AGBCP2 region | _     | 0.0054      |
| BIGC      | Parameter for Igc  | _     | 0           |
| BIGSD     | Parameter for Igs,d  |       | 0           |
| BINUNIT   | Bin unit selector  | _     | 1           |
| BJTOFF    | BJT on/off flag  | _     | 0           |
| CAPMOD    | Capacitance model selector   | _     | 2           |
| CBJTII    | Length scaling parameter for II BJT part   | m     | 0           |
| CDSBS     | coupling from Vd to Vbs for improved dVbi model                                  | _     | 0           |
| CDSC      | Drain/Source and channel coupling capacitance                                    | _     | 0.00024     |
| CDSCB     | Body-bias dependence of cdsc   | _     | 0           |
| CDSCD     | Drain-bias dependence of cdsc  |       | 0           |
| CF        | Fringe capacitance parameter   |       | 0           |
| CFRCOEFF  | Fringe Cap parameter /* v4.4   | _     | 1           |
| CGDL      | New C-V model parameter  | _     | 0           |
| CGDO      | Gate-drain overlap capacitance per width   | _     | 0           |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| CGEO      | Gate substrate overlap capacitance per unit channel length                      | _     | 0       |
| CGIDL     | GIDL vb parameter   | _     | 0.5     |
| CGISL     | GISL vb parameter   | _     | 0       |
| CGSL      | New C-V model parameter   | _     | 0       |
| CGSO      | Gate-source overlap capacitance per width                                       |       | 0       |
| CIGBCP2   | Third Vgp dependent parameter for gate current in accumulation in AGBCP2 region | _     | 0.0075  |
| CIGC      | Parameter for Igc   | _     | 0       |
| CIGSD     | Parameter for Igs,d   |       | 0       |
| CIT       | Interface state capacitance   | _     | 0       |
| CJSWG     | Source(gate side) sidewall junction capacitance per unit width /* v4.0          | _     | 1e-10   |
| CJSWGD    | Drain (gate side) sidewall junction capacitance per unit width /* v4.0          | _     | 0       |
| CKAPPA    | New C-V model parameter   | _     | 0.6     |
| CLC       | Vdsat parameter for C-V model   | m     | 1e-08   |
| CLE       | Vdsat parameter for C-V model   | _     | 0       |
| CSDESW    | Source/drain sidewall fringing capacitance per unit length                      | _     | 0       |
| CSDMIN    | Source/drain bottom diffusion minimum capacitance                               | V     | 0       |
| CTH0      | Instance Thermal Capacitance  | _     | 1e-05   |
| DELTA     | Effective Vds parameter   |       | 0.01    |
| DELTAVOX  | the smoothing parameter in the Vox smoothing function                           | _     | 0.005   |
| DELVT     | Threshold voltage adjust for CV   | V     | 0       |
| DELVTO    | Zero bias threshold voltage variation   | V     | 0       |
| DK2B      | third backgate body effect parameter for short channel effect                   | _     | 0       |
| DLBG      | Length offset fitting parameter for backgate charge                             | m     | 0       |
| DLC       | Delta L for C-V model   | m     | 0       |
| DLCB      | Length offset fitting parameter for body charge                                 | m     | 0       |
| DLCIG     | Delta L for Ig model  | m     | 0       |
| DROUT     | DIBL coefficient of output resistance   | _     | 0.56    |
| DSUB      | DIBL coefficient in the subthreshold region                                     | _     | 0       |
| DTOXCV    | Delta oxide thickness in meters in CapMod3 /* v2.2.3                            | m     | 0       |
| DVBD0     | first short-channel effect parameter in FD module                               | _     | 0       |
| DVBD1     | second short-channel effect parameter in FD module                              | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DVT0      | Short channel effect coeff. 0                            | _     | 2.2     |
| DVT0W     | Narrow Width coeff. 0                                    |       | 0       |
| DVT1      | Short channel effect coeff. 1                            | _     | 0.53    |
| DVT1W     | Narrow Width effect coeff. 1                             | _     | 5.3e+06 |
| DVT2      | Short channel effect coeff. 2                            | _     | -0.032  |
| DVT2W     | Narrow Width effect coeff. 2                             | _     | -0.032  |
| DVTP0     | First parameter for Vth shift due to pocket              | m     | 0       |
| DVTP1     | Second parameter for Vth shift due to pocket             | _     | 0       |
| DVTP2     | Third parameter for Vth shift due to pocket              |       | 0       |
| DVTP3     | Third parameter for Vth shift due to pocket              | _     | 0       |
| OVTP4     | Forth parameter for Vth shift due to pocket              | _     | 0       |
| DWB       | Width reduction parameter                                | _     | 0       |
| DWBC      | Width offset for body contact isolation edge             | m     | 0       |
| DWC       | Delta W for C-V model                                    | m     | 0       |
| DWG       | Width reduction parameter                                | m/V   | 0       |
| EASUB     | Electron affinity of substrate                           | _     | 4.05    |
| EBG       | effective bandgap in gate current calculation            | _     | 1.2     |
| EBJTII    | Impact ionization parameter for BJT part                 | _     | 0       |
| GF        | Flicker noise frequency exponent                         | _     | 1       |
| EGGBCP2   | Bandgap in Agbcp2 region                                 | _     | 1.12    |
| EGGDEP    | Bandgap for gate depletion effect                        | _     | 1.12    |
| EGIDL     | GIDL first parameter                                     | V     | 0       |
| EGISL     | GISL first parameter                                     | V     | 0       |
| ΣM        | Flicker noise parameter                                  | _     | 4.1e+07 |
| EOT       | Effective SiO2 thickness                                 | m     | 1e-08   |
| EPSRGATE  | Dielectric constant of gate relative to vacuum           | _     | 11.7    |
| EPSROX    | Dielectric constant of the gate oxide relative to vacuum | _     | 3.9     |
| EPSRSUB   | Dielectric constant of substrate relative to vacuum      | _     | 11.7    |
| ESATII    | Saturation electric field for impact ionization          | _     | 1e+07   |
| ETAO      | Subthreshold region DIBL coefficient for I-V             | _     | 0.08    |
| ETAOCV    | Subthreshold region DIBL coefficient for C-V             | _     | 0       |
| ETAB      | Subthreshold region DIBL coefficient for I-V             | _     | -0.07   |
| ETABCV    | Subthreshold region DIBL coefficient for C-V             | _     | 0       |
| ETSI      | Effective Silicon-on-insulator thickness in meters       | m     | 1e-07   |
| EU        | Mobility exponent  |       | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| FBJTII    | Fraction of bipolar current affecting the impact ionization    | _     | 0       |
| FBODY     | Scaling factor for body charge                                 | _     | 1       |
| FDMOD     | Improved dVbi model selector                                   | _     | 0       |
| FGIDL     | GIDL vb parameter  | _     | 0       |
| FGISL     | GISL vb parameter  | V     | 0       |
| FNOIMOD   | Flicker noise model selector                                   | _     | 1       |
| FPROUT    | Rout degradation coefficient for pocket devices                | _     | 0       |
| FRBODY    | layout dependent body-resistance coefficient                   | _     | 1       |
| GAMMA1    | Vth body coefficient   | _     | 0       |
| GAMMA2    | Vth body coefficient   | _     | 0       |
| GBMIN     | Minimum body conductance                                       | _     | 1e-12   |
| GIDLMOD   | parameter for GIDL selector                                    | _     | 0       |
| IDBJT     | BJT injection saturation current                               | _     | 0       |
| IDDIF     | Body to source/drain injection saturation current /* v4.0      | _     | 0       |
| IDREC     | Recombination in depletion saturation current                  |       | 0       |
| IDTUN     | Reverse tunneling saturation current                           |       | 0       |
| IGBMOD    | gate-body tunneling current model selector /* v3.0             | _     | 0       |
| IGCMOD    | gate-channel tunneling current model selector /* v3.0          | _     | 0       |
| IGMOD     | gate-body tunneling current model selector /* v3.1.1           | _     | 0       |
| IIIMOD    | parameter for III selector                                     | _     | 0       |
| ISBJT     | BJT injection saturation current                               | _     | 1e-06   |
| ISDIF     | Body to source/drain injection saturation current              | _     | 0       |
| ISREC     | Recombination in depletion saturation current                  | _     | 1e-05   |
| ISTUN     | Reverse tunneling saturation current                           | _     | 0       |
| K1        | Bulk effect coefficient 1                                      | _     | 0.53    |
| K1B       | first backgate body effect parameter                           | _     | 1       |
| K1W1      | First Body effect width dependent parameter                    | m     | 0       |
| K1W2      | Second Body effect width dependent parameter                   | m     | 0       |
| K2        | Bulk effect coefficient 2                                      | _     | -0.0186 |
| K2B       | second backgate body effect parameter for short channel effect | _     | 0       |
| К3        | Narrow width effect coefficient                                |       | 0       |
| КЗВ       | Body effect coefficient of k3                                  | _     | 0       |
| KB1       | Scaling factor for backgate charge                             | _     | 1       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| KETA      | Body-bias coefficient of non-uniform depletion width effect.  | _     | -0.6    |
| KETAS     | Surface potential adjustment for bulk charge effect           | V     | 0       |
| KF        | Flicker noise coefficient                                     | _     | 0       |
| KGIDL     | GIDL vb parameter   | V     | 0       |
| KGISL     | GISL vb parameter   | V     | 0       |
| KT1       | Temperature coefficient of Vth                                | V     | -0.11   |
| KT1L      | Temperature coefficient of Vth                                | _     | 0       |
| KT2       | Body-coefficient of kt1                                       | _     | 0.022   |
| KU0       | Mobility degradation/enhancement coefficient for LOD          | m     | 0       |
| KVSAT     | Saturation velocity degradation/enhancement parameter for LOD | m     | 0       |
| KVTH0     | Threshold degradation/enhancement parameter for LOD           | Vm    | 0       |
| L         | Length  | m     | 5e-06   |
| LA0       | Length dependence of a0                                       | _     | 0       |
| LA1       | Length dependence of a1                                       | _     | 0       |
| LA2       | Length dependence of a2                                       | _     | 0       |
| LABJTII   | Length dependence of abjtii                                   | _     | 0       |
| LACDE     | Length dependence of acde                                     | _     | 0       |
| LAELY     | Length dependence of aely                                     | _     | 0       |
| LAGIDL    | Length dependence of agidl                                    | _     | 0       |
| LAGISL    | Length dependence of agisl                                    | _     | 0       |
| LAGS      | Length dependence of ags                                      | _     | 0       |
| LAHLI     | Length dependence of ahli /*v4.0                              | _     | 0       |
| LAHLID    | Length dependence of ahlid /*v4.0                             | _     | 0       |
| LAIGBCP2  | Length dependence of aigbcp2                                  | _     | 0       |
| LAIGC     | Length dependence of aigc                                     | _     | 0       |
| LAIGSD    | Length dependence of aigsd                                    | _     | 0       |
| LALPHA0   | Length dependence of alpha0                                   | _     | 0       |
| LALPHAGB1 | Length dependence of alphagb1                                 |       | 0       |
| LALPHAGB2 | Length dependence of alphagb2                                 |       | 0       |
| LAT       | Length dependence of at                                       | _     | 0       |
| LB0       | Length dependence of b0                                       | _     | 0       |
| LB1       | Length dependence of b1                                       | _     | 0       |
| LBETA0    | Length dependence of beta0                                    | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LBETA1    | Length dependence of beta1                             | _     | 0       |
| LBETA2    | Length dependence of beta2                             | _     | 0       |
| LBETAGB1  | Length dependence of betagb1                           | _     | 0       |
| LBETAGB2  | Length dependence of betagb2                           | _     | 0       |
| LBGIDL    | Length dependence of bgidl                             | _     | 0       |
| LBGISL    | Length dependence of bgisl                             | _     | 0       |
| LBIGBCP2  | Length dependence of bigbcp2                           | _     | 0       |
| LBIGC     | Length dependence of bigc                              | _     | 0       |
| LBIGSD    | Length dependence of bigsd                             | _     | 0       |
| LBJT0     | Reference channel length for bipolar current           | m     | 2e-07   |
| LCBJTII   | Length dependence of cbjtii                            | _     | 0       |
| LCDSBS    | Length dependence of cdsbs                             | _     | 0       |
| LCDSC     | Length dependence of cdsc                              | _     | 0       |
| LCDSCB    | Length dependence of cdscb                             | _     | 0       |
| LCDSCD    | Length dependence of cdscd                             | _     | 0       |
| LCGDL     | Length dependence of cgdl                              | _     | 0       |
| LCGIDL    | Length dependence of cgidl                             | _     | 0       |
| LCGISL    | Length dependence of cgisl                             | _     | 0       |
| LCGSL     | Length dependence of cgsl                              | _     | 0       |
| LCIGBCP2  | Length dependence of cigbcp2                           | _     | 0       |
| LCIGC     | Length dependence of cigc                              | _     | 0       |
| LCIGSD    | Length dependence of cigsd                             | _     | 0       |
| LCIT      | Length dependence of cit                               | _     | 0       |
| LCKAPPA   | Length dependence of ckappa                            | _     | 0       |
| LDELTA    | Length dependence of delta                             | _     | 0       |
| LDELVT    | Length dependence of delvt                             | _     | 0       |
| LDIF0     | Channel-length dependency coefficient of diffusion cap | _     | 1       |
| LDK2B     | Length dependence of dk2b                              | _     | 0       |
| LDROUT    | Length dependence of drout                             | _     | 0       |
| LDSUB     | Length dependence of dsub                              | _     | 0       |
| LDVBD0    | Length dependence of dvbd0                             | _     | 0       |
| LDVBD1    | Length dependence of dvbd1                             | _     | 0       |
| LDVT0     | Length dependence of dvt0                              | _     | 0       |
| LDVTOW    | Length dependence of dvt0w                             | _     | 0       |
|           | Length dependence of dvt1                              |       |         |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| LDVT1W    | Length dependence of dvt1w  | _     | 0       |
| LDVT2     | Length dependence of dvt2   | _     | 0       |
| LDVT2W    | Length dependence of dvt2w  | _     | 0       |
| LDVTP0    | Length dependence of dvtp0  | _     | 0       |
| LDVTP1    | Length dependence of dvtp1  | _     | 0       |
| LDVTP2    | Length dependence of dvtp2  | _     | 0       |
| LDVTP3    | Length dependence of dvtp3  | _     | 0       |
| LDVTP4    | Length dependence of dvtp4  | _     | 0       |
| LDWB      | Length dependence of dwb  | _     | 0       |
| LDWG      | Length dependence of dwg  | _     | 0       |
| LEBJTII   | Length dependence of ebjtii   | _     | 0       |
| LEFFEOT   | Effective length for extraction of EOT  | _     | 1       |
| LEGIDL    | Length dependence of egidl  | _     | 0       |
| LEGISL    | Length dependence of egisl  | _     | 0       |
| LESATII   | Length dependence of esatii   | _     | 0       |
| LETA0     | Length dependence of eta0   | _     | 0       |
| LETA0CV   | Length dependence of eta0cv   | _     | 0       |
| LETAB     | Length dependence of etab   | _     | 0       |
| LETABCV   | Length dependence of etabcv   | _     | 0       |
| LEU       | Length dependence of eu   | _     | 0       |
| LFBJTII   | Length dependence of fbjtii   | _     | 0       |
| LFGIDL    | Length dependence of fgidl  | _     | 0       |
| LFGISL    | Length dependence of fgisl  | _     | 0       |
| LFPROUT   | Length dependence of pdiblcb  | _     | 0       |
| LIDBJT    | Length dependence of idbjt  | _     | 0       |
| LIDDIF    | Length dependence of iddif  | _     | 0       |
| LIDREC    | Length dependence of idrec  | _     | 0       |
| LIDTUN    | Length dependence of idtun  | _     | 0       |
| LII       | Channel length dependent parameter at threshold for impact ionization current | _     | 0       |
| LINT      | Length reduction parameter  | m     | 0       |
| LISBJT    | Length dependence of isbjt  | _     | 0       |
| LISDIF    | Length dependence of isdif  | _     | 0       |
| LISREC    | Length dependence of isrec  | _     | 0       |
| LISTUN    | Length dependence of istun  | _     | 0       |
| <br>JK1   | Length dependence of k1   | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                          | Units | Default |
|-----------|--------------------------------------|-------|---------|
| LK1B      | Length dependence of k1b             | _     | 0       |
| LK1W1     | Length dependence of k1w1            | _     | 0       |
| LK1W2     | Length dependence of k1w2            | _     | 0       |
| LK2       | Length dependence of k2              | _     | 0       |
| LK2B      | Length dependence of k2b             | _     | 0       |
| LK3       | Length dependence of k3              | _     | 0       |
| LK3B      | Length dependence of k3b             | _     | 0       |
| LKB1      | Length dependence of kb1             | _     | 0       |
| LKETA     | Length dependence of keta            | _     | 0       |
| LKETAS    | Length dependence of ketas           | _     | 0       |
| LKGIDL    | Length dependence of kgidl           | _     | 0       |
| LKGISL    | Length dependence of kgisl           | _     | 0       |
| LKT1      | Length dependence of kt1             | _     | 0       |
| LKT1L     | Length dependence of kt11            | _     | 0       |
| LKT2      | Length dependence of kt2             | _     | 0       |
| LKU0      | Length dependence of ku0             | _     | 0       |
| LKVTH0    | Length dependence of kvth0           | _     | 0       |
| LL        | Length reduction parameter           | m     | 0       |
| LLBJT0    | Length dependence of lbjt0           | _     | 0       |
| LLC       | Length reduction parameter /* v2.2.3 | _     | 0       |
| LLII      | Length dependence of lii             | _     | 0       |
| LLN       | Length reduction parameter           | _     | 1       |
| LLODKU0   | Length parameter for u0 LOD effect   | _     | 0       |
| LLODVTH   | Length parameter for vth LOD effect  | _     | 0       |
| LLPE0     | Length dependence of lpe0            | _     | 0       |
| LLPEB     | Length dependence of lpeb            | _     | 0       |
| LMBJTII   | Length dependence of mbjtii          | _     | 0       |
| LMINV     | Length dependence of minv            | _     | 0       |
| LMINVCV   | Length dependence of minvcv          | _     | 0       |
| LMOIN     | Length dependence of moin            | _     | 0       |
| LMOINFD   | Length dependence of moinfd          | _     | 0       |
| LN        | Electron/hole diffusion length       | m     | 2e-06   |
| LNBJT     | Length dependence of nbjt            | _     | 0       |
| LNCH      | Length dependence of nch             | _     | 0       |
| LNDIF     | Length dependence of ndif            | _     | 0       |
| LNDIODE   | Length dependence of ndiode          | _     | 0       |
|           | - <del>*</del>                       |       |         |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LNDIODED  | Length dependence of ndioded                       | _     | 0       |
| LNFACTOR  | Length dependence of nfactor                       | _     | 0       |
| LNGATE    | Length dependence of ngate                         | _     | 0       |
| LNGIDL    | Length dependence of ngidl                         | _     | 0       |
| LNIGC     | Length dependence of nigc                          | _     | 0       |
| LNLX      | Length dependence of nlx                           | _     | 0       |
| LNOFF     | Length dependence of noff /* v3.2                  | _     | 0       |
| LNOFF2    | Length dependence of noff2 /* v4.6                 | _     | 0       |
| LNOFFFD   | Length dependence of nofffd                        | _     | 0       |
| LNRECF0   | Length dependence of nrecf0                        | _     | 0       |
| LNRECF0D  | Length dependence of nrecf0d                       | _     | 0       |
| LNRECR0   | Length dependence of nrecr0                        | _     | 0       |
| LNRECR0D  | Length dependence of nrecr0d                       | _     | 0       |
| LNSD      | Length dependence of nsd                           | _     | 0       |
| LNSUB     | Length dependence of nsub                          | _     | 0       |
| LNTRECF   | Length dependence of ntrecf                        | _     | 0       |
| LNTRECR   | Length dependence of ntrecr                        | _     | 0       |
| LNTUN     | Length dependence of ntun                          | _     | 0       |
| LNTUND    | Length dependence of ntund                         | _     | 0       |
| LODETA0   | eta0 shift modification factor for stress effect   | _     | 1       |
| LODETA0CV | eta0cv shift modification factor for stress effect | _     | 0       |
| LODK2     | K2 shift modification factor for stress effect     | _     | 1       |
| LPCLM     | Length dependence of pclm                          | _     | 0       |
| LPDIBLC1  | Length dependence of pdiblc1                       | _     | 0       |
| LPDIBLC2  | Length dependence of pdiblc2                       | _     | 0       |
| LPDIBLCB  | Length dependence of pdiblcb                       | _     | 0       |
| LPDITS    | Length dependence of pdits                         | _     | 0       |
| LPDITSD   | Length dependence of pditsd                        | _     | 0       |
| LPE0      | Lateral non-uniform doping effect                  | m     | 0       |
| LPEB      | Lateral non-uniform doping effect for body bias    | m     | 0       |
| LPIGCD    | Length dependence for pigcd                        | _     | 0       |
| LPOXEDGE  | Length dependence for poxedge                      | _     | 0       |
| LPRT      | Length dependence of prt                           | _     | 0       |
| LPRWB     | Length dependence of prwb                          | _     | 0       |
| LPRWG     | Length dependence of prwg                          | _     | 0       |
| LPVAG     | Length dependence of pvag                          | _     | 0       |
|           |  |       |         |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                      | Units | Default |
|-----------|----------------------------------|-------|---------|
| LRDSW     | Length dependence of rdsw        | _     | 0       |
| LRDW      | Length dependence of rdw /* v4.0 | _     | 0       |
| LRGIDL    | Length dependence of rgidl       | _     | 0       |
| LRGISL    | Length dependence of rgisl       | _     | 0       |
| LRSW      | Length dependence of rsw /* v4.0 | _     | 0       |
| LSII0     | Length dependence of sii0        | _     | 0       |
| LSII1     | Length dependence of sii1        | _     | 0       |
| LSII2     | Length dependence of sii2        | _     | 0       |
| LSIID     | Length dependence of siid        | _     | 0       |
| LU0       | Length dependence of u0          | _     | 0       |
| LUA       | Length dependence of ua          | _     | 0       |
| LUA1      | Length dependence of ua1         | _     | 0       |
| LUB       | Length dependence of ub          | _     | 0       |
| LUB1      | Length dependence of ub1         | _     | 0       |
| LUC       | Length dependence of uc          | _     | 0       |
| LUC1      | Length dependence of uc1         | _     | 0       |
| LUCS      | Length dependence of lucs        | _     | 0       |
| LUCSTE    | Length dependence of ucste       | _     | 0       |
| LUD       | Length dependence of ud          | _     | 0       |
| LUD1      | Length dependence of ud1         | _     | 0       |
| LUTE      | Length dependence of ute         | _     | 0       |
| LVABJT    | Length dependence of vabjt       | _     | 0       |
| LVBCI     | Length dependence of vbci        | _     | 0       |
| LVBS0FD   | Length dependence of vbs0fd      | _     | 0       |
| LVBS0PD   | Length dependence of vbs0pd      | _     | 0       |
| LVBSA     | Length dependence of vbsa        | _     | 0       |
| LVDSATII0 | Length dependence of vdsatii0    | _     | 0       |
| LVFB      | Length dependence of vfb /* v4.1 | _     | 0       |
| LVOFF     | Length dependence of voff        | _     | 0       |
| LVOFFCV   | Length dependence of voffcv      | _     | 0       |
| LVOFFFD   | Length dependence of vofffd      | _     | 0       |
| LVREC0    | Length dependence of vrec0       | _     | 0       |
| LVREC0D   | Length dependence of vrec0d      | _     | 0       |
| LVSAT     | Length dependence of vsat        | _     | 0       |
| LVSCE     | Length dependence of vsce        | _     | 0       |
| LVSDFB    | Length dependence of vsdfb       | _     | 0       |
|           |                                  |       |         |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LVSDTH    | Length dependence of vsdth   |       | 0       |
| LVTH0     | Length dependence of vto   | _     | 0       |
| LVTUN0    | Length dependence of vtun0   | _     | 0       |
| LVTUN0D   | Length dependence of vtun0d  | _     | 0       |
| LW        | Length reduction parameter   | m     | 0       |
| LW0       | Length dependence of w0  | _     | 0       |
| LWC       | Length reduction parameter /* v2.2.3   | _     | 0       |
| LWL       | Length reduction parameter   | _     | 0       |
| LWLC      | Length reduction parameter /* v2.2.3   | _     | 0       |
| LWN       | Length reduction parameter   | _     | 1       |
| LWR       | Length dependence of wr  | _     | 0       |
| LXBJT     | Length dependence of xbjt  | _     | 0       |
| LXDIF     | Length dependence of xdif  | _     | 0       |
| LXDIFD    | Length dependence of xdifd   |       | 0       |
| LXJ       | Length dependence of xj  |       | 0       |
| LXRCRG1   | Length dependence of xrcrg1  | _     | 0       |
| LXRCRG2   | Length dependence of xrcrg2  | _     | 0       |
| LXREC     | Length dependence of xrec  | _     | 0       |
| LXRECD    | Length dependence of xrecd   | _     | 0       |
| LXTUN     | Length dependence of xtun  | _     | 0       |
| LXTUND    | Length dependence of xtund   | _     | 0       |
| MBJTII    | Internal B-C grading coefficient   | _     | 0.4     |
| MINV      | For moderate inversion in Vgsteff  | _     | 0       |
| MINVCV    | For moderate inversion in VgsteffCV  | _     | 0       |
| MJSWG     | Source (gate side) sidewall junction capacitance grading coefficient /* v4.0 | V     | 0.5     |
| MJSWGD    | Drain (gate side) sidewall junction capacitance grading coefficient /* v4.0  | V     | 0       |
| MOBMOD    | Mobility model selector  | _     | 1       |
| MOIN      | Coefficient for the gate-bias dependent surface potential                    | _     | 15      |
| MOINFD    | Coefficient for the gate-bias dependent surface potential in FD              |       | 1000    |
| MTRLMOD   | parameter for non-silicon substrate or metal gate selector                   | _     | 0       |
| NBC       | Number of body contact isolation edge  |       | 0       |
| NBJT      | Power coefficient of channel length dependency for bipolar current           | _     | 1       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default  |
|-----------|--|-------|----------|
| NCH       | Channel doping concentration   | _     | 1.7e+17  |
| NDIF      | Power coefficient of channel length dependency for diffusion capacitance | _     | -1       |
| NDIODE    | Diode non-ideality factor /*v4.0   | _     | 1        |
| NDIODED   | Diode non-ideality factor /*v4.0   | _     | 0        |
| NF        | Number of fingers  | _     | 1        |
| NFACTOR   | Subthreshold swing Coefficient   | _     | 1        |
| NGATE     | Poly-gate doping concentration   | _     | 0        |
| NGCON     | Number of gate contacts  | _     | 1        |
| NGIDL     | GIDL first parameter   | _     | 1.2      |
| NIOSUB    | Intrinsic carrier concentration of substrate at Tnom                     | _     | 1.45e+10 |
| NIGC      | Parameter for Igc slope  | _     | 1        |
| NLX       | Lateral non-uniform doping effect  | m     | 1.74e-07 |
| NODECHK   | NODE checking flag   | _     | 1        |
| NOFF      | C-V turn-on/off parameter /* v3.2  | _     | 1        |
| NOFF2     | C-V turn-on/off parameter /* v4.6  | _     | 0        |
| NOFFFD    | smoothing parameter in FD module   | _     | 1        |
| NOIA      | Flicker noise parameter  | _     | 0        |
| NOIB      | Flicker noise parameter  | _     | 0        |
| NOIC      | Flicker noise parameter  | _     | 8.75e+09 |
| NOIF      | Floating body excess noise ideality factor                               | _     | 1        |
| NRB       | Number of squares in body  | _     | 1        |
| NRD       | Number of squares in drain   | _     | 1        |
| NRECF0    | Recombination non-ideality factor at forward bias                        | _     | 2        |
| NRECF0D   | Recombination non-ideality factor at forward bias                        | _     | 0        |
| NRECRO    | Recombination non-ideality factor at reversed bias                       | _     | 10       |
| NRECR0D   | Recombination non-ideality factor at reversed bias                       | _     | 0        |
| NRS       | Number of squares in source  | _     | 1        |
| NSD       | S/D doping concentration   | _     | 1e+20    |
| NSEG      | Number segments for width partitioning                                   | _     | 1        |
| NSUB      | Substrate doping concentration with polarity                             | _     | 6e+16    |
| NTNOI     | Thermal noise parameter  | _     | 1        |
| NTOX      | power term of gate current   | _     | 1        |
| NTRECF    | Temperature coefficient for Nrecf  | _     | 0        |
| NTRECR    | Temperature coefficient for Nrecr  | _     | 0        |
| NTUN      | Reverse tunneling non-ideality factor                                    | _     | 10       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| NTUND     | Reverse tunneling non-ideality factor                                      | _     | 0       |
| OFF       | Device is initially off  | _     | 0       |
| PA0       | Cross-term dependence of a0  | _     | 0       |
| PA1       | Cross-term dependence of a1  | _     | 0       |
| PA2       | Cross-term dependence of a2  | _     | 0       |
| PABJTII   | Cross-term dependence of abjtii  | _     | 0       |
| PACDE     | Cross-term dependence of acde  | _     | 0       |
| PAELY     | Cross-term dependence of aely  | _     | 0       |
| PAGIDL    | Cross-term dependence of agidl   | _     | 0       |
| PAGISL    | Cross-term dependence of agisl   | _     | 0       |
| PAGS      | Cross-term dependence of ags   | _     | 0       |
| PAHLI     | X-term dependence of ahli /* v4.0  | _     | 0       |
| PAHLID    | X-term dependence of ahlid /* v4.0   | _     | 0       |
| PAIGBCP2  | Cross-term dependence of aigbcp2   | _     | 0       |
| PAIGC     | Cross-term dependence of aigc  | _     | 0       |
| PAIGSD    | Cross-term dependence of aigsd   | _     | 0       |
| PALPHA0   | Cross-term dependence of alpha0  | _     | 0       |
| PALPHAGB1 | Cross-term dependence of alphagb1  | _     | 0       |
| PALPHAGB2 | Cross-term dependence of alphagb2  | _     | 0       |
| PARAMCHK  | Model parameter checking selector  | _     | 0       |
| PAT       | Cross-term dependence of at  | _     | 0       |
| PB0       | Cross-term dependence of b0  | _     | 0       |
| PB1       | Cross-term dependence of b1  | _     | 0       |
| PBETA0    | Cross-term dependence of beta0   | _     | 0       |
| PBETA1    | Cross-term dependence of beta1   | _     | 0       |
| PBETA2    | Cross-term dependence of beta2   | _     | 0       |
| PBETAGB1  | Cross-term dependence of betagb1   | _     | 0       |
| PBETAGB2  | Cross-term dependence of betagb2   | _     | 0       |
| PBGIDL    | Cross-term dependence of bgidl   | _     | 0       |
| PBGISL    | Cross-term dependence of bgisl   | _     | 0       |
| PBIGBCP2  | Cross-term dependence of bigbcp2   | _     | 0       |
| PBIGC     | Cross-term dependence of bigc  | _     | 0       |
| PBIGSD    | Cross-term dependence of bigsd   | _     | 0       |
| PBSWG     | Source(gate side) sidewall junction capacitance built in potential /* v4.0 | V     | 0.7     |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PBSWGD    | Drain(gate side) sidewall junction capacitance built in potential /* v4.0 | V     | 0       |
| PCBJTII   | Cross-term dependence of cbjtii   | _     | 0       |
| PCDSBS    | Cross-term dependence of cdsbs  | _     | 0       |
| PCDSC     | Cross-term dependence of cdsc   | _     | 0       |
| PCDSCB    | Cross-term dependence of cdscb  |       | 0       |
| PCDSCD    | Cross-term dependence of cdscd  | _     | 0       |
| PCGDL     | Cross-term dependence of cgdl   | _     | 0       |
| PCGIDL    | Cross-term dependence of cgidl  | _     | 0       |
| PCGISL    | Cross-term dependence of cgisl  | _     | 0       |
| PCGSL     | Cross-term dependence of cgsl   | _     | 0       |
| PCIGBCP2  | Cross-term dependence of cigbcp2  | _     | 0       |
| PCIGC     | Cross-term dependence of cigc   | _     | 0       |
| PCIGSD    | Cross-term dependence of cigsd  | _     | 0       |
| PCIT      | Cross-term dependence of cit  | _     | 0       |
| PCKAPPA   | Cross-term dependence of ckappa   | _     | 0       |
| PCLM      | Channel length modulation Coefficient                                     | _     | 1.3     |
| PD        | Drain perimeter   | m     | 0       |
| PDBCP     | Perimeter length for bc parasitics at drain side                          | m     | 0       |
| PDELTA    | Cross-term dependence of delta  | _     | 0       |
| PDELVT    | Cross-term dependence of delvt  | _     | 0       |
| PDIBLC1   | Drain-induced barrier lowering coefficient                                | _     | 0.39    |
| PDIBLC2   | Drain-induced barrier lowering coefficient                                | _     | 0.0086  |
| PDIBLCB   | Body-effect on drain-induced barrier lowering                             | _     | 0       |
| PDITS     | Coefficient for drain-induced Vth shifts                                  | _     | 1e-20   |
| PDITSD    | Vds dependence of drain-induced Vth shifts                                | _     | 0       |
| PDITSL    | Length dependence of drain-induced Vth shifts                             | _     | 0       |
| PDK2B     | Cross-term dependence of dk2b   | _     | 0       |
| PDROUT    | Cross-term dependence of drout  | _     | 0       |
| PDSUB     | Cross-term dependence of dsub   | _     | 0       |
| PDVBD0    | Cross-term dependence of dvbd0  | _     | 0       |
| PDVBD1    | Cross-term dependence of dvbd1  | _     | 0       |
| PDVT0     | Cross-term dependence of dvt0   | _     | 0       |
| PDVT0W    | Cross-term dependence of dvt0w  | _     | 0       |
| PDVT1     | Cross-term dependence of dvt1   |       | 0       |
| PDVT1W    | Cross-term dependence of dvt1w  |       | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| PDVT2         Cross-term dependence of dvt2         —         0           PDVTPQW         Cross-term dependence of dvtpQ         —         0           PDVTPQ         Cross-term dependence of dvtpQ         —         0           PDVTP1         Cross-term dependence of dvtpQ         —         0           PDVTP2         Cross-term dependence of dvtp3         —         0           PDVTP3         Cross-term dependence of dvtp3         —         0           PDVTP4         Cross-term dependence of dvtp4         —         0           PDWB         Cross-term dependence of dwg         —         0           PDWG         Cross-term dependence of dwg         —         0           PEBJIII         Cross-term dependence of epidi         —         0           PEGISL         Cross-term dependence of epidi         —         0           PEGATII         Cross-term dependence of epidi         —         0           PETAO         Cross-term dependence of eta0         —         0           PETAB         Cross-term dependence of eta0         —         0           PETABCV         Cross-term dependence of etabcv         —         0           PETABCV         Cross-term dependence of etabcv         —         0 <th><b>D</b>efault</th>   | <b>D</b> efault |
|--|-----------------|
| PDVTP0         Cross-term dependence of dvtp0         —         0           PDVTP1         Cross-term dependence of dvtp1         —         0           PDVTP2         Cross-term dependence of dvtp2         —         0           PDVTP3         Cross-term dependence of dvtp3         —         0           PDVTP4         Cross-term dependence of dvtp4         —         0           PDWB         Cross-term dependence of dwg         —         0           PDWG         Cross-term dependence of dwg         —         0           PEBJT11         Cross-term dependence of egidl         —         0           PEGIDL         Cross-term dependence of egidl         —         0           PEGISL         Cross-term dependence of egidl         —         0           PEGISL         Cross-term dependence of esatii         —         0           PETA0         Cross-term dependence of eta0         —         0           PETAB         Cross-term dependence of eta0         —         0           PETAB         Cross-term dependence of etabcv         —         0           PETABCV         Cross-term dependence of etabcv         —         0           PETABCV         Cross-term dependence of figidl         —         0 </td <td></td>   |                 |
| PDVTP1         Cross-term dependence of dvtp1         —         0           PDVTP2         Cross-term dependence of dvtp2         —         0           PDVTP3         Cross-term dependence of dvtp3         —         0           PDVTP4         Cross-term dependence of dvtp4         —         0           PDWB         Cross-term dependence of dwb         —         0           PDWG         Cross-term dependence of dwb         —         0           PEBJT11         Cross-term dependence of ebytii         —         0           PEGIDL         Cross-term dependence of egidl         —         0           PEGISL         Cross-term dependence of egidl         —         0           PEGISL         Cross-term dependence of egisl         —         0           PEGISL         Cross-term dependence of esatti         —         0           PETA0         Cross-term dependence of eta0         —         0           PETA0         Cross-term dependence of eta0         —         0           PETAB         Cross-term dependence of etabcv         —         0           PETABCV         Cross-term dependence of etabcv         —         0           PFBJT11         Cross-term dependence of fgidl         —         0 </td <td></td>   |                 |
| PDVTP2         Cross-term dependence of dvtp3         —         0           PDVTP3         Cross-term dependence of dvtp4         —         0           PDVTP4         Cross-term dependence of dvtp4         —         0           PDWB         Cross-term dependence of dwb         —         0           PDWG         Cross-term dependence of dwg         —         0           PEBJTII         Cross-term dependence of dwg         —         0           PEGIBL         Cross-term dependence of epidi         —         0           PEGISL         Cross-term dependence of epidi         —         0           PESATII         Cross-term dependence of epidi         —         0           PETA0         Cross-term dependence of eta0         —         0           PETA0         Cross-term dependence of eta0         —         0           PETA0CV         Cross-term dependence of etab         —         0           PETAB         Cross-term dependence of etab         —         0           PEU         Cross-term dependence of bptiii         —         0           PFBJTII         Cross-term dependence of bptii         —         0           PFGIBL         Cross-term dependence of fgidl         —         0     <   |                 |
| PDVTP3         Cross-term dependence of dvtp4         —         0           PDVTP4         Cross-term dependence of dvtp4         —         0           PDWB         Cross-term dependence of dwb         —         0           PDWG         Cross-term dependence of dwg         —         0           PEBJTII         Cross-term dependence of dwg         —         0           PEBJTII         Cross-term dependence of eigidl         —         0           PEGISL         Cross-term dependence of eigidl         —         0           PESATII         Cross-term dependence of esatii         —         0           PETA0         Cross-term dependence of eta0         —         0           PETA0         Cross-term dependence of etab         —         0           PETA0         Cross-term dependence of ibitii         —         0 <td></td>  |                 |
| PDVTP4         Cross-term dependence of dvtp4         —         0           PDWB         Cross-term dependence of dwb         —         0           PDWG         Cross-term dependence of dwg         —         0           PEBJTII         Cross-term dependence of wgg         —         0           PEGIDL         Cross-term dependence of egidl         —         0           PEGISL         Cross-term dependence of egisl         —         0           PESATII         Cross-term dependence of esatti         —         0           PETA0         Cross-term dependence of eta0         —         0           PETAB         Cross-term dependence of etabcv         —         0           PEU         Cross-term dependence of figiti         —         0   |                 |
| PDWB         Cross-term dependence of dwb         —         0           PDWG         Cross-term dependence of dwg         —         0           PEBJTII         Cross-term dependence of egidl         —         0           PEGIDL         Cross-term dependence of egidl         —         0           PEGISL         Cross-term dependence of egisl         —         0           PETA0         Cross-term dependence of esatii         —         0           PETA0         Cross-term dependence of eta0         —         0           PETA0         Cross-term dependence of eta0         —         0           PETAB         Cross-term dependence of eta0         —         0           PEU         Cross-term dependence of tea0         —         0           PFBJULI         Cross-term dependence of figidl         —         0      <  |                 |
| PDWG       Cross-term dependence of dwg       —       0         PEBJTII       Cross-term dependence of ebjtii       —       0         PEGIDL       Cross-term dependence of egidl       —       0         PEGISL       Cross-term dependence of egisl       —       0         PESATII       Cross-term dependence of esatii       —       0         PETA0       Cross-term dependence of eta0       —       0         PETAB       Cross-term dependence of eta0       —       0         PEU       Cross-term dependence of eta0       —       0         PEU       Cross-term dependence of figit       —       0         PFGISL       Cross-term dependence of figit       —       0         PFGISL       Cross-term dependence of idbjt       —       0         PIDBJT       Cross-term dependence of idc0       —       0  |                 |
| PEBJTII       Cross-term dependence of ebitii       —       0         PEGIDL       Cross-term dependence of egidl       —       0         PEGISL       Cross-term dependence of egisl       —       0         PESATII       Cross-term dependence of esatii       —       0         PETAO       Cross-term dependence of etaOv       —       0         PETABCV       Cross-term dependence of etaBov       —       0         PETABEV       Cross-term dependence of etaBov       —       0         PEU       Cross-term dependence of etaBov       —       0         PEBJTII       Cross-term dependence of etaBov       —       0         PFBJTII       Cross-term dependence of etaBov       —       0         PFBJTII       Cross-term dependence of etaBov       —       0         PFBJTII       Cross-term dependence of bitii       —       0         PFBJTII       Cross-term dependence of figial       —       0         PFGISL       Cross-term dependence of figisl       —       0         PFPROUT       Cross-term dependence of jablicb       —       0         PHIG       Work function of gate       —       4.0         PIDDJT       Cross-term dependence of iddif       —<  |                 |
| PEGIDL       Cross-term dependence of egidl       —       0         PEGISL       Cross-term dependence of egisl       —       0         PESATII       Cross-term dependence of esatii       —       0         PETAO       Cross-term dependence of eta0       —       0         PETAOCV       Cross-term dependence of eta0cv       —       0         PETABE       Cross-term dependence of etab       —       0         PETABEV       Cross-term dependence of etabcv       —       0         PETABEV       Cross-term dependence of etabcv       —       0         PEU       Cross-term dependence of etabcv       —       0         PEU       Cross-term dependence of etabcv       —       0         PFBJTII       Cross-term dependence of figiti       —       0         PFBJTII       Cross-term dependence of figidl       —       0         PFGISL       Cross-term dependence of pdiblcb       —       0         PFPROUT       Cross-term dependence of idbjt       —       0         PHIG       Work function of gate       —       4.0         PIDBJT       Cross-term dependence of iddif       —       0         PIDREC       Cross-term dependence of idden       —   |                 |
| PEGISL       Cross-term dependence of egisl       —       0         PESATII       Cross-term dependence of esatii       —       0         PETAO       Cross-term dependence of etaOcv       —       0         PETADCV       Cross-term dependence of etaDcv       —       0         PETAB       Cross-term dependence of etab       —       0         PETABCV       Cross-term dependence of etabcv       —       0         PEU       Cross-term dependence of etabcv       —       0         PFBJTII       Cross-term dependence of etabcv       —       0         PFGIDL       Cross-term dependence of figitl       —       0         PFGISL       Cross-term dependence of figitl       —       0         PFFROUT       Cross-term dependence of pdiblcb       —       0         PFPROUT       Cross-term dependence of pdiblcb       —       0         PHIG       Work function of gate       —       4.0         PIDBJT       Cross-term dependence of idbjt       —       0         PIDREC       Cross-term dependence of iddif       —       0         PIDTUN       Cross-term dependence of idtun       —       0         PISBJT       Cross-term dependence of isbjt       —   |                 |
| PESATII       Cross-term dependence of esatii       —       0         PETAO       Cross-term dependence of etaO       —       0         PETAOCV       Cross-term dependence of etaOcv       —       0         PETAB       Cross-term dependence of etabcv       —       0         PETABCV       Cross-term dependence of etabcv       —       0         PEU       Cross-term dependence of eu       —       0         PFBJTII       Cross-term dependence of figiti       —       0         PFGIDL       Cross-term dependence of figitl       —       0         PFGISL       Cross-term dependence of figisl       —       0         PFPROUT       Cross-term dependence of pdiblcb       —       0         PHIG       Work function of gate       —       4.0         PIDBJT       Cross-term dependence of idbjt       —       0         PIDREC       Cross-term dependence of iddif       —       0         PIDREC       Cross-term dependence of idun       —       0         PISBJT       Cross-term dependence of isbjt       —       0         PISBJT       Cross-term dependence of isbjt       —       0         PISREC       Cross-term dependence of istun       — <td< td=""><td></td></td<>  |                 |
| PETA0 Cross-term dependence of eta0 — 0 PETA0CV Cross-term dependence of eta0cv — 0 PETAB Cross-term dependence of etab — 0 PETABCV Cross-term dependence of etabcv — 0 PEU Cross-term dependence of etabcv — 0 PFBJTII Cross-term dependence of fbjtii — 0 PFGIDL Cross-term dependence of fgidl — 0 PFGROUT Cross-term dependence of fgisl — 0 PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of idrec — 0 PIDTUN Cross-term dependence of idun — 0 PISSBJT Cross-term dependence of isbjt — 0 PISSTUN Cross-term dependence of istun — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of klb — 0   |                 |
| PETADCV Cross-term dependence of etabcv — 0 PETABE Cross-term dependence of etab — 0 PETABCV Cross-term dependence of etabcv — 0 PEU Cross-term dependence of eu — 0 PFBJTII Cross-term dependence of bjtii — 0 PFGIDL Cross-term dependence of fgidl — 0 PFGISL Cross-term dependence of fgisl — 0 PFPROUT Cross-term dependence of pdiblcb — 0 PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of idrec — 0 PISSBJT Cross-term dependence of idtun — 0 PISSBJT Cross-term dependence of isbjt — 0 |                 |
| PETAB       Cross-term dependence of etabcv       —       0         PEU       Cross-term dependence of eu       —       0         PFBJTII       Cross-term dependence of fbjtii       —       0         PFGIDL       Cross-term dependence of fgidl       —       0         PFGISL       Cross-term dependence of fgisl       —       0         PFPROUT       Cross-term dependence of pdiblcb       —       0         PHIG       Work function of gate       —       4.0         PIDBJT       Cross-term dependence of idbjt       —       0         PIDDIF       Cross-term dependence of iddif       —       0         PIDREC       Cross-term dependence of idtun       —       0         PIGCD       Parameter for Igc partition       —       1         PISBJT       Cross-term dependence of isbjt       —       0         PISDIF       Cross-term dependence of isidif       —       0         PISREC       Cross-term dependence of isidif       —       0         PISTUN       Cross-term dependence of isitun       —       0         PK1       Cross-term dependence of istun       —       0         PK1B       Cross-term dependence of k1b       —       0     <  |                 |
| PETABCV Cross-term dependence of etabcv — 0 PEU Cross-term dependence of eu — 0 PFBJTII Cross-term dependence of fbjtii — 0 PFGIDL Cross-term dependence of fgidl — 0 PFGISL Cross-term dependence of fgisl — 0 PFPROUT Cross-term dependence of pdiblcb — 0 PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of iddif — 0 PIDTUN Cross-term dependence of idtun — 0 PIGCD Parameter for Igc partition — 1 PISBJT Cross-term dependence of isbjt — 0 PISDIF Cross-term dependence of isbjt — 0 PISTUN Cross-term dependence of isbjt — 0 PISTUN Cross-term dependence of istun — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of istun — 0 PK1 Cross-term dependence of k1 — 0   |                 |
| PEU Cross-term dependence of eu — 0 PFBJTII Cross-term dependence of fbjtii — 0 PFGIDL Cross-term dependence of fgidl — 0 PFGISL Cross-term dependence of fgisl — 0 PFPROUT Cross-term dependence of pdiblcb — 0 PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of idrec — 0 PIDTUN Cross-term dependence of idrec — 0 PISBJT Cross-term dependence of idtun — 0 PISSBJT Cross-term dependence of isbjt — 0 PISSBJT Cross-term dependence of isbjt — 0 PISSBJT Cross-term dependence of isbjt — 0 PISSDIF Cross-term dependence of isidif — 0 PISREC Cross-term dependence of isidif — 0 PISTUN Cross-term dependence of istun — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of istun — 0  |                 |
| PFBJTII Cross-term dependence of fbjtii — 0 PFGIDL Cross-term dependence of fgidl — 0 PFGISL Cross-term dependence of fgisl — 0 PFPROUT Cross-term dependence of pdiblob — 0 PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of idrec — 0 PIDTUN Cross-term dependence of idtun — 0 PIGCD Parameter for Igc partition — 1 PISBJT Cross-term dependence of isbjt — 0 PISREC Cross-term dependence of isdif — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of istun — 0 PK1 Cross-term dependence of k1 — 0   |                 |
| PFGIDL Cross-term dependence of fgidl — 0 PFGISL Cross-term dependence of fgisl — 0 PFPROUT Cross-term dependence of pdiblcb — 0 PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of idrec — 0 PIDTUN Cross-term dependence of idtun — 0 PIGCD Parameter for Igc partition — 1 PISBJT Cross-term dependence of isbjt — 0 PISREC Cross-term dependence of isdif — 0 PISREC Cross-term dependence of isdif — 0 PISTUN Cross-term dependence of isdif — 0 PISTUN Cross-term dependence of isdif — 0 PK1 Cross-term dependence of istun — 0 PK1 Cross-term dependence of k1 — 0 PK1B Cross-term dependence of k1b — 0   |                 |
| PFGISL Cross-term dependence of fgisl — 0  PFPROUT Cross-term dependence of pdiblcb — 0  PHIG Work function of gate — 4.0  PIDBJT Cross-term dependence of idbjt — 0  PIDDIF Cross-term dependence of iddif — 0  PIDREC Cross-term dependence of idrec — 0  PIDTUN Cross-term dependence of idtun — 0  PIGCD Parameter for Igc partition — 1  PISBJT Cross-term dependence of isbjt — 0  PISDIF Cross-term dependence of isdif — 0  PISTUN Cross-term dependence of isdif — 0  PISTUN Cross-term dependence of istun — 0  PK1 Cross-term dependence of istun — 0  PK1B Cross-term dependence of k1b — 0  |                 |
| PFPROUT  Cross-term dependence of pdiblcb  PHIG  Work function of gate  Cross-term dependence of idbjt  PIDBJT  Cross-term dependence of iddif  PIDDIF  Cross-term dependence of iddif  PIDREC  Cross-term dependence of idrec  PIDTUN  Cross-term dependence of idtun  PIGCD  Parameter for Igc partition  PISBJT  Cross-term dependence of isbjt  PISBJT  Cross-term dependence of isbjt  PISDIF  Cross-term dependence of isidif  PISREC  Cross-term dependence of isrec  PISTUN  Cross-term dependence of istun  PK1  Cross-term dependence of istun  PK1  Cross-term dependence of k1  Cross-term dependence of k1  Cross-term dependence of k1b  Cross-term dependence of k1b  |                 |
| PHIG Work function of gate — 4.0 PIDBJT Cross-term dependence of idbjt — 0 PIDDIF Cross-term dependence of iddif — 0 PIDTUN Cross-term dependence of idtun — 0 PIGCD Parameter for Igc partition — 1 PISBJT Cross-term dependence of isbjt — 0 PISDIF Cross-term dependence of isdif — 0 PISTUN Cross-term dependence of isdif — 0 PISTUN Cross-term dependence of isdif — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of k1 — 0 PK1 Cross-term dependence of k1 — 0   |                 |
| PIDBJT       Cross-term dependence of idbjt       —       0         PIDDIF       Cross-term dependence of iddif       —       0         PIDREC       Cross-term dependence of idrec       —       0         PIDTUN       Cross-term dependence of iddun       —       0         PIGCD       Parameter for Igc partition       —       1         PISBJT       Cross-term dependence of isbjt       —       0         PISDIF       Cross-term dependence of isdif       —       0         PISREC       Cross-term dependence of isrec       —       0         PISTUN       Cross-term dependence of istun       —       0         PK1       Cross-term dependence of k1       —       0         PK1B       Cross-term dependence of k1b       —       0  |                 |
| PIDDIF Cross-term dependence of iddif — 0 PIDREC Cross-term dependence of idrec — 0 PIDTUN Cross-term dependence of idtun — 0 PIGCD Parameter for Igc partition — 1 PISBJT Cross-term dependence of isbjt — 0 PISDIF Cross-term dependence of isdif — 0 PISREC Cross-term dependence of isrec — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of k1 — 0 PK1B Cross-term dependence of k1b — 0  | .05             |
| PIDREC Cross-term dependence of idrec — 0 PIDTUN Cross-term dependence of idtun — 0 PIGCD Parameter for Igc partition — 1 PISBJT Cross-term dependence of isbjt — 0 PISDIF Cross-term dependence of isdif — 0 PISREC Cross-term dependence of isrec — 0 PISTUN Cross-term dependence of istun — 0 PK1 Cross-term dependence of k1 — 0 PK1B Cross-term dependence of k1b — 0  |                 |
| PIDTUN       Cross-term dependence of idtun       —       0         PIGCD       Parameter for Igc partition       —       1         PISBJT       Cross-term dependence of isbjt       —       0         PISDIF       Cross-term dependence of isdif       —       0         PISREC       Cross-term dependence of isrec       —       0         PISTUN       Cross-term dependence of istun       —       0         PK1       Cross-term dependence of k1       —       0         PK1B       Cross-term dependence of k1b       —       0  |                 |
| PIGCD       Parameter for Igc partition       —       1         PISBJT       Cross-term dependence of isbjt       —       0         PISDIF       Cross-term dependence of isdif       —       0         PISREC       Cross-term dependence of isrec       —       0         PISTUN       Cross-term dependence of istun       —       0         PK1       Cross-term dependence of k1       —       0         PK1B       Cross-term dependence of k1b       —       0  |                 |
| PISBJT       Cross-term dependence of isbjt       —       0         PISDIF       Cross-term dependence of isdif       —       0         PISREC       Cross-term dependence of isrec       —       0         PISTUN       Cross-term dependence of istun       —       0         PK1       Cross-term dependence of k1       —       0         PK1B       Cross-term dependence of k1b       —       0  |                 |
| PISDIF       Cross-term dependence of isdif       —       0         PISREC       Cross-term dependence of isrec       —       0         PISTUN       Cross-term dependence of istun       —       0         PK1       Cross-term dependence of k1       —       0         PK1B       Cross-term dependence of k1b       —       0  |                 |
| PISREC     Cross-term dependence of isrec     —     0       PISTUN     Cross-term dependence of istun     —     0       PK1     Cross-term dependence of k1     —     0       PK1B     Cross-term dependence of k1b     —     0  |                 |
| PISTUN     Cross-term dependence of istun     —     0       PK1     Cross-term dependence of k1     —     0       PK1B     Cross-term dependence of k1b     —     0  |                 |
| PK1     Cross-term dependence of k1     —     0       PK1B     Cross-term dependence of k1b     —     0  |                 |
| PK1B Cross-term dependence of k1b — 0  |                 |
| •  |                 |
| PK1W1 Cross-term dependence of k1w1 — 0  |                 |
|  |                 |
| PK1W2 Cross-term dependence of k1w2 — 0  |                 |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| PK2B         Cross-term dependence of k2b         —         0           PK3         Cross-term dependence of k3         —         0           PK3B         Cross-term dependence of k3b         —         0           PKB1         Cross-term dependence of kb1         —         0           PKETA         Cross-term dependence of keta         —         0           PKETAS         Cross-term dependence of ketas         —         0           PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgisl         —         0           PKT1         Cross-term dependence of kt1         —         0  | Parameter | Description                            | Units | Default |
|--|-----------|--|-------|---------|
| PK3         Cross-term dependence of k3b         —         0           PK3B         Cross-term dependence of k3b         —         0           PKB1         Cross-term dependence of kb1         —         0           PKETA         Cross-term dependence of keta         —         0           PKETAS         Cross-term dependence of ketas         —         0           PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgidl         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT2         Cross-term dependence of kt1         —         0           PKU0         Cross-term dependence of ku0         —         0           PKVT10         Cross-term dependence of ku0         —         0           PKVT10         Cross-term dependence of bjt0         —         0           PKVT10         Cross-term dependence of lbjt0         —         0           PLLI         Cross-term dependence of lbjt0         —         0           PLIJI         Cross-term dependence of lpe0         —         0           <  | PK2       | Cross-term dependence of k2            | _     | 0       |
| FX3B         Cross-term dependence of kb1         —         0           PKB1         Cross-term dependence of kb1         —         0           PKETA         Cross-term dependence of keta         —         0           PKETAS         Cross-term dependence of ketas         —         0           PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgidl         —         0           PKT1         Cross-term dependence of kgidl         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT2         Cross-term dependence of kt1         —         0           PKT2         Cross-term dependence of ku0         —         0           PKW10         Cross-term dependence of ku0         —         0           PKW10         Cross-term dependence of kv10         —         0           PKW10         Cross-term dependence of lbi0         —         0           PKW10         Cross-term dependence of lbi0         —         0           PLDETO         Cross-term dependence of lipe0         —         0           PLDEDE         Cross-term dependence of lipe0         —         0   | PK2B      | Cross-term dependence of k2b           | _     | 0       |
| PKB1         Cross-term dependence of keta         —         0           PKETA         Cross-term dependence of keta         —         0           PKETAS         Cross-term dependence of ketas         —         0           PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgidl         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT2         Cross-term dependence of kt2         —         0           PKU0         Cross-term dependence of ku0         —         0           PKU0         Cross-term dependence of ku0         —         0           PKU0         Cross-term dependence of ku0         —         0           PLDETO         Cross-term dependence of lbjt0         —         0           PLF1         Cross-term dependence of lbjt0         —         0           PLPED         Cross-term dependence of lpe0         —         0           PMBJTII         Cross-term dependence of miniv         —         0  | PK3       | Cross-term dependence of k3            | _     | 0       |
| PKETA         Cross-term dependence of keta         —         0           PKETAS         Cross-term dependence of ketas         —         0           PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgisl         —         0           PKT1         Cross-term dependence of ktl         —         0           PKT1L         Cross-term dependence of ktll         —         0           PKT2         Cross-term dependence of ktl         —         0           PKU0         Cross-term dependence of ktl         —         0           PKVTH0         Cross-term dependence of kvlh         —         0           PKVTH0         Cross-term dependence of kvlh         —         0           PLBJT0         Cross-term dependence of lijt         —         0           PLII         Cross-term dependence of lijt         —         0           PLII         Cross-term dependence of lipe         —         0           PLPEB         Cross-term dependence of lipe         —         0           PMBJT11         Cross-term dependence of miniv         —         0           PMINVV         Cross-term dependence of miniv         —         0 <t< td=""><td>PK3B</td><td>Cross-term dependence of k3b</td><td>_</td><td>0</td></t<>  | PK3B      | Cross-term dependence of k3b           | _     | 0       |
| PKETAS         Cross-term dependence of ketas         —         0           PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgisl         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT1L         Cross-term dependence of kt1         —         0           PKT2         Cross-term dependence of kt2         —         0           PKU0         Cross-term dependence of ku0         —         0           PKVTH0         Cross-term dependence of kv10         —         0           PLBJT0         Cross-term dependence of lbi0         —         0           PLII         Cross-term dependence of lii         —         0           PLFEO         Cross-term dependence of lpe0         —         0           PLFEB         Cross-term dependence of lpeb         —         0           PMIJTII         Cross-term dependence of minv         —         0           PMINVCV         Cross-term dependence of minv         —         0           PMINVCV         Cross-term dependence of moin         —         0           PMOINFD         Cross-term dependence of moin         —         0      <  | PKB1      | Cross-term dependence of kb1           | _     | 0       |
| PKGIDL         Cross-term dependence of kgidl         —         0           PKGISL         Cross-term dependence of kgisl         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT1L         Cross-term dependence of kt1         —         0           PKT2         Cross-term dependence of kt2         —         0           PKU0         Cross-term dependence of ku0         —         0           PKVTH0         Cross-term dependence of kvth0         —         0           PLBJT0         Cross-term dependence of lpit0         —         0           PLBJT1         Cross-term dependence of lpit0         —         0           PLFE0         Cross-term dependence of lpe0         —         0           PLFEB         Cross-term dependence of lpeb         —         0           PMBJT11         Cross-term dependence of lpeb         —         0           PMINV         Cross-term dependence of minv         —         0           PMINVUV         Cross-term dependence of minv         —         0           PMOIN         Cross-term dependence of moinf         —         0           PMOINFD         Cross-term dependence of moinf         —         0   | PKETA     | Cross-term dependence of keta          | _     | 0       |
| PKGISL         Cross-term dependence of kgisl         —         0           PKT1         Cross-term dependence of kt1         —         0           PKT2L         Cross-term dependence of kt1         —         0           PKU0         Cross-term dependence of kt2         —         0           PKU0         Cross-term dependence of ku0         —         0           PKVTH0         Cross-term dependence of kvth0         —         0           PLBJT0         Cross-term dependence of lbjt0         —         0           PLII         Cross-term dependence of lbjt0         —         0           PLFE0         Cross-term dependence of lpe0         —         0           PLFEB         Cross-term dependence of lpe0         —         0           PMINTI         Cross-term dependence of mbjtii         —         0           PMINTI         Cross-term dependence of minve         —         0           PMINTI         Cross-term dependence of minve         —         0           PMINTI         Cross-term dependence of minve         —         0           PMOIN         Cross-term dependence of moin         —         0           PMOINFD         Cross-term dependence of moin         —         0  | PKETAS    | Cross-term dependence of ketas         | _     | 0       |
| PKT1   | PKGIDL    | Cross-term dependence of kgidl         | _     | 0       |
| PKT1L         Cross-term dependence of kt1l         —         0           PKT2         Cross-term dependence of kt2         —         0           PKU0         Cross-term dependence of ku0         —         0           PKVTH0         Cross-term dependence of kvth0         —         0           PLBJT0         Cross-term dependence of lbjt0         —         0           PLBJT1         Cross-term dependence of lii         —         0           PLPEB         Cross-term dependence of lpe0         —         0           PMBJT11         Cross-term dependence of lpeb         —         0           PMINV         Cross-term dependence of minv         —         0           PMINV         Cross-term dependence of minv         —         0           PMOIN         Cross-term dependence of minv         —         0           PMOIN         Cross-term dependence of moin         —         0           PMOINFD         Cross-term dependence of moinfd         —         0           PNBJT         Cross-term dependence of nch         —         0           PNDL         Cross-term dependence of nch         —         0           PNDIFF         Cross-term dependence of ndide         —         0 <tr< td=""><td>PKGISL</td><td>Cross-term dependence of kgisl</td><td>_</td><td>0</td></tr<>   | PKGISL    | Cross-term dependence of kgisl         | _     | 0       |
| PKT2 Cross-term dependence of kt2 — 0  PKU0 Cross-term dependence of ku0 — 0  PKVTHO Cross-term dependence of kvthO — 0  PLEJTO Cross-term dependence of lbjtO — 0  PLII Cross-term dependence of lbjtO — 0  PLEPEO Cross-term dependence of lpeO — 0  PLEPEB Cross-term dependence of lpeO — 0  PMBJTII Cross-term dependence of lpeb — 0  PMINV Cross-term dependence of minV — 0  PMINV Cross-term dependence of minV — 0  PMOIN Cross-term dependence of minV — 0  PMOIN Cross-term dependence of minV — 0  PMOIN Cross-term dependence of moin — 0  PNDJT Cross-term dependence of moinfd — 0  PNDJT Cross-term dependence of nbjt — 0  PNDLH Cross-term dependence of nbjt — 0  PNDLH Cross-term dependence of nch — 0  PNDLE Cross-term dependence of ndif — 0  PNDLE Cross-term dependence of ndif — 0  PNDLE Cross-term dependence of ndide — 0  PNDLODE Cross-term dependence of ndide — 0  PNDLODE Cross-term dependence of ndide — 0  PNGATE Cross-term dependence of ngate — 0  PNGATE Cross-term dependence of ngate — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNIGF Cross-term dependence of nigc — 0  PNIGF Cross-term dependence of nigc — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF Cross-term dependence of noff /* v4.6 — 0  | PKT1      | Cross-term dependence of kt1           | _     | 0       |
| PKUO Cross-term dependence of kuO — 0  PKVTHO Cross-term dependence of kvthO — 0  PLBJTO Cross-term dependence of lbjtO — 0  PLBJTO Cross-term dependence of lbjtO — 0  PLII Cross-term dependence of lii — 0  PLPEO Cross-term dependence of lpeO — 0  PLPEB Cross-term dependence of lpeD — 0  PMBJTII Cross-term dependence of mbjtii — 0  PMINV Cross-term dependence of minv — 0  PMINVOV Cross-term dependence of minvov — 0  PMOIN Cross-term dependence of moin — 0  PMOIN Cross-term dependence of moinfd — 0  PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nbjt — 0  PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndidod — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of ngate — 0  PNGATE Cross-term dependence of ngate — 0  PNIGC Cross-term dependence of nigC  PNIGC Cross-term dependence of nlix — 0  PNOFF Cross-term dependence of noff?* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.66 — 0   | PKT1L     | Cross-term dependence of kt11          | _     | 0       |
| PRVTHO         Cross-term dependence of kvth0         —         0           PLEJTO         Cross-term dependence of lbjt0         —         0           PLII         Cross-term dependence of lbjt0         —         0           PLPE0         Cross-term dependence of lpe0         —         0           PLPEB         Cross-term dependence of lpeb         —         0           PMBJTII         Cross-term dependence of mbjtii         —         0           PMINV         Cross-term dependence of minv         —         0           PMINVCV         Cross-term dependence of minvcv         —         0           PMOIN         Cross-term dependence of moin         —         0           PMOINFD         Cross-term dependence of moinfd         —         0           PNBJT         Cross-term dependence of nbjt         —         0           PNCH         Cross-term dependence of nch         —         0           PNDIF         Cross-term dependence of ndif         —         0           PNDIODE         Cross-term dependence of ndiode         —         0           PNFACTOR         Cross-term dependence of ndiode         —         0           PNGATE         Cross-term dependence of ngate         —         0 <td>PKT2</td> <td>Cross-term dependence of kt2</td> <td>_</td> <td>0</td>   | PKT2      | Cross-term dependence of kt2           | _     | 0       |
| PLEJTO Cross-term dependence of lbjtO — 0 PLII Cross-term dependence of lii — 0 PLPEO Cross-term dependence of lpeO — 0 PLPEB Cross-term dependence of lpeO — 0 PMBJTII Cross-term dependence of mbjtii — 0 PMINV Cross-term dependence of minv — 0 PMINVCV Cross-term dependence of minvcv — 0 PMOIN Cross-term dependence of moin — 0 PMOINFD Cross-term dependence of moinfd — 0 PNBJT Cross-term dependence of nbjt — 0 PNCH Cross-term dependence of nbjt — 0 PNDIF Cross-term dependence of nch — 0 PNDIF Cross-term dependence of ndif — 0 PNDIF Cross-term dependence of ndif — 0 PNDIODE Cross-term dependence of ndiode — 0 PNDIODE Cross-term dependence of ndiode — 0 PNGATE Cross-term dependence of nfactor — 0 PNGATE Cross-term dependence of ngate — 0 PNGIDL Cross-term dependence of nige — 0 PNIGC Cross-term dependence of nige — 0 PNIGC Cross-term dependence of nige — 0 PNICK Cross-term dependence of nige — 0 | PKU0      | Cross-term dependence of ku0           | _     | 0       |
| PLII Cross-term dependence of lii — 0 PLPEO Cross-term dependence of lpeO — 0 PLPEB Cross-term dependence of lpeb — 0 PMBJTII Cross-term dependence of mbjtii — 0 PMINVV Cross-term dependence of minvcv — 0 PMINVCV Cross-term dependence of minvcv — 0 PMOIN Cross-term dependence of moin — 0 PMOINFD Cross-term dependence of moinfd — 0 PNBJT Cross-term dependence of nbjt — 0 PNCH Cross-term dependence of nch — 0 PNDIF Cross-term dependence of nch — 0 PNDIF Cross-term dependence of ndif — 0 PNDIF Cross-term dependence of ndif — 0 PNDIODE Cross-term dependence of ndiode — 0 PNFACTOR Cross-term dependence of nfactor — 0 PNGATE Cross-term dependence of ngate — 0 PNGIDL Cross-term dependence of ngidl — 0 PNIGC Cross-term dependence of nigc — 0 PNICC Cross-term dependence of nigc — 0  | PKVTH0    | Cross-term dependence of kvth0         | _     | 0       |
| PLPED Cross-term dependence of lpe0 — 0 PLPEB Cross-term dependence of lpeb — 0 PMBJTII Cross-term dependence of mbjtii — 0 PMINV Cross-term dependence of minv — 0 PMINVCV Cross-term dependence of minvcv — 0 PMOIN Cross-term dependence of moin — 0 PMOINFD Cross-term dependence of moinfd — 0 PNBJT Cross-term dependence of nbjt — 0 PNCH Cross-term dependence of nbjt — 0 PNDIF Cross-term dependence of ndif — 0 PNDIF Cross-term dependence of ndif — 0 PNDIF Cross-term dependence of ndide — 0 PNDIODE Cross-term dependence of ndiode — 0 PNFACTOR Cross-term dependence of nfactor — 0 PNGATE Cross-term dependence of ngate — 0 PNGIDL Cross-term dependence of ngidl — 0 PNIGC Cross-term dependence of nigc — 0                                     | PLBJT0    | Cross-term dependence of lbjt0         | _     | 0       |
| PLPEB Cross-term dependence of lpeb — 0  PMBJTII Cross-term dependence of mbjtii — 0  PMINV Cross-term dependence of minv — 0  PMINVCV Cross-term dependence of minvcv — 0  PMOIN Cross-term dependence of moin — 0  PMOINFD Cross-term dependence of moinfd — 0  PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nch — 0  PNDIF Cross-term dependence of ndif — 0  PNDIF Cross-term dependence of ndiode — 0  PNDIODE Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngate — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nlix — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2/* v4.6 — 0   | PLII      | Cross-term dependence of lii           | _     | 0       |
| PMBJTII Cross-term dependence of mbjtii — 0  PMINV Cross-term dependence of minv — 0  PMINVCV Cross-term dependence of minvcv — 0  PMOIN Cross-term dependence of moin — 0  PMOINFD Cross-term dependence of moinfd — 0  PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nch — 0  PNDIF Cross-term dependence of ndif — 0  PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNIGDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF Cross-term dependence of noff2 /* v4.6 — 0   | PLPE0     | Cross-term dependence of lpe0          | _     | 0       |
| PMINV Cross-term dependence of minv — 0  PMINVCV Cross-term dependence of minvcv — 0  PMOIN Cross-term dependence of moin — 0  PMOINFD Cross-term dependence of moinfd — 0  PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nch — 0  PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndiode — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNIGOL Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0   | PLPEB     | Cross-term dependence of lpeb          | _     | 0       |
| PMINVCV Cross-term dependence of minvcv — 0  PMOIN Cross-term dependence of moin — 0  PMOINFD Cross-term dependence of moinfd — 0  PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nch — 0  PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndiode — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0   | PMBJTII   | Cross-term dependence of mbjtii        | _     | 0       |
| PMOIN Cross-term dependence of moin — 0  PMOINFD Cross-term dependence of moinfd — 0  PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nch — 0  PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndiode — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNIGC Cross-term dependence of nigc — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PMINV     | Cross-term dependence of minv          | _     | 0       |
| PMOINFD Cross-term dependence of moinfd — 0 PNBJT Cross-term dependence of nbjt — 0 PNCH Cross-term dependence of nch — 0 PNDIF Cross-term dependence of ndif — 0 PNDIF Cross-term dependence of ndiode — 0 PNDIODE Cross-term dependence of ndiode — 0 PNDIODED Cross-term dependence of ndiode — 0 PNFACTOR Cross-term dependence of nfactor — 0 PNGATE Cross-term dependence of ngate — 0 PNGIDL Cross-term dependence of ngidl — 0 PNIGC Cross-term dependence of nigc — 0 PNIGC Cross-term dependence of nigc — 0 PNLX Cross-term dependence of nlx — 0 PNOFF Cross-term dependence of noff /* v3.2 — 0 PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0   | PMINVCV   | Cross-term dependence of minvcv        | _     | 0       |
| PNBJT Cross-term dependence of nbjt — 0  PNCH Cross-term dependence of nch — 0  PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndiode — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff2 /* v4.6 — 0  | PMOIN     | Cross-term dependence of moin          | _     | 0       |
| PNCH Cross-term dependence of nch — 0 PNDIF Cross-term dependence of ndif — 0 PNDIODE Cross-term dependence of ndiode — 0 PNDIODED Cross-term dependence of ndiode — 0 PNFACTOR Cross-term dependence of nfactor — 0 PNGATE Cross-term dependence of ngate — 0 PNGIDL Cross-term dependence of ngidl — 0 PNIGC Cross-term dependence of nigc — 0 PNLX Cross-term dependence of nigc — 0 PNOFF Cross-term dependence of noff /* v3.2 — 0 PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PMOINFD   | Cross-term dependence of moinfd        | _     | 0       |
| PNDIF Cross-term dependence of ndif — 0  PNDIODE Cross-term dependence of ndiode — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNBJT     | Cross-term dependence of nbjt          | _     | 0       |
| PNDIODE Cross-term dependence of ndiode — 0  PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0   | PNCH      | Cross-term dependence of nch           | _     | 0       |
| PNDIODED Cross-term dependence of ndiode — 0  PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNDIF     | Cross-term dependence of ndif          | _     | 0       |
| PNFACTOR Cross-term dependence of nfactor — 0  PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNDIODE   | Cross-term dependence of ndiode        | _     | 0       |
| PNGATE Cross-term dependence of ngate — 0  PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0   | PNDIODED  | Cross-term dependence of ndiode        | _     | 0       |
| PNGIDL Cross-term dependence of ngidl — 0  PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNFACTOR  | Cross-term dependence of nfactor       | _     | 0       |
| PNIGC Cross-term dependence of nigc — 0  PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0   | PNGATE    | Cross-term dependence of ngate         | _     | 0       |
| PNLX Cross-term dependence of nlx — 0  PNOFF Cross-term dependence of noff /* v3.2 — 0  PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNGIDL    | Cross-term dependence of ngidl         | _     | 0       |
| PNOFF Cross-term dependence of noff /* v3.2 — 0 PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNIGC     | Cross-term dependence of nigc          | _     | 0       |
| PNOFF2 Cross-term dependence of noff2 /* v4.6 — 0  | PNLX      | Cross-term dependence of nlx           | _     | 0       |
|  | PNOFF     | Cross-term dependence of noff /* v3.2  | _     | 0       |
|  | PNOFF2    | Cross-term dependence of noff2 /* v4.6 | _     | 0       |
|  | PNOFFFD   |  | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                                       | Units | Default |
|-----------|---|-------|---------|
| PNRECF0   | Cross-term dependence of nrecf0                   | _     | 0       |
| PNRECF0D  | Cross-term dependence of nrecf0                   | _     | 0       |
| PNRECR0   | Cross-term dependence of nrecr0                   | _     | 0       |
| PNRECROD  | Cross-term dependence of nrecr0                   | _     | 0       |
| PNSD      | Cross-term dependence of nsd                      | _     | 0       |
| PNSUB     | Cross-term dependence of nsub                     | _     | 0       |
| PNTRECF   | Cross-term dependence of ntrecf                   | _     | 0       |
| PNTRECR   | Cross-term dependence of ntrecr                   | _     | 0       |
| PNTUN     | Cross-term dependence of ntun                     | _     | 0       |
| PNTUND    | Cross-term dependence of ntund                    | _     | 0       |
| POXEDGE   | Factor for the gate edge Tox                      | _     | 1       |
| PPCLM     | Cross-term dependence of pclm                     | _     | 0       |
| PPDIBLC1  | Cross-term dependence of pdiblc1                  | _     | 0       |
| PPDIBLC2  | Cross-term dependence of pdiblc2                  | _     | 0       |
| PPDIBLCB  | Cross-term dependence of pdiblcb                  | _     | 0       |
| PPDITS    | Cross-term dependence of pdits                    | _     | 0       |
| PPDITSD   | Cross-term dependence of pditsd                   | _     | 0       |
| PPIGCD    | Cross-term dependence for pigcd                   | _     | 0       |
| PPOXEDGE  | Cross-term dependence for poxedge                 | _     | 0       |
| PPRT      | Cross-term dependence of prt                      | _     | 0       |
| PPRWB     | Cross-term dependence of prwb                     | _     | 0       |
| PPRWG     | Cross-term dependence of prwg                     | _     | 0       |
| PPVAG     | Cross-term dependence of pvag                     | _     | 0       |
| PRDSW     | Cross-term dependence of rdsw                     | _     | 0       |
| PRDW      | Cross-term dependence of rdw /*v4.0               | _     | 0       |
| PRGIDL    | Cross-term dependence of rgidl                    | _     | 0       |
| PRGISL    | Cross-term dependence of rgisl                    | _     | 0       |
| PRSW      | Cross-term dependence of rsw /*v4.0               | _     | 0       |
| PRT       | Temperature coefficient of parasitic resistance   | _     | 0       |
| PRWB      | Body-effect on parasitic resistance               | _     | 0       |
| PRWG      | Gate-bias effect on parasitic resistance          | _     | 0       |
| PS        | Source perimeter                                  | m     | 0       |
| PSBCP     | Perimeter length for bc parasitics at source side | m     | 0       |
| PSII0     | Cross-term dependence of sii0                     | _     | 0       |
| PSII1     | Cross-term dependence of sii1                     | _     | 0       |
| PSII2     | Cross-term dependence of sii2                     |       | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                                    | Units | Default |
|-----------|--|-------|---------|
| PSIID     | Cross-term dependence of siid                  | _     | 0       |
| PU0       | Cross-term dependence of u0                    | _     | 0       |
| PUA       | Cross-term dependence of ua                    | _     | 0       |
| PUA1      | Cross-term dependence of ua1                   | _     | 0       |
| PUB       | Cross-term dependence of ub                    | _     | 0       |
| PUB1      | Cross-term dependence of ub1                   | _     | 0       |
| PUC       | Cross-term dependence of uc                    | _     | 0       |
| PUC1      | Cross-term dependence of uc1                   | _     | 0       |
| PUCS      | Cross-term dependence of ucs                   | _     | 0       |
| PUCSTE    | Cross-term dependence of ucste                 | _     | 0       |
| PUD       | Cross-term dependence of ud                    | _     | 0       |
| PUD1      | Cross-term dependence of ud1                   |       | 0       |
| PUTE      | Cross-term dependence of ute                   | _     | 0       |
| PVABJT    | Cross-term dependence of vabjt                 |       | 0       |
| PVAG      | Gate dependence of output resistance parameter |       | 0       |
| PVBCI     | Cross-term dependence of vbci                  | _     | 0       |
| PVBS0FD   | Cross-term dependence of vbs0fd                | _     | 0       |
| PVBS0PD   | Cross-term dependence of vbs0pd                | _     | 0       |
| PVBSA     | Cross-term dependence of vbsa                  | _     | 0       |
| PVDSATII0 | Cross-term dependence of vdsatii0              | _     | 0       |
| PVFB      | Cross-term dependence of vfb /* v4.1           | _     | 0       |
| PVOFF     | Cross-term dependence of voff                  | _     | 0       |
| PVOFFCV   | Cross-term dependence of voffcv                | _     | 0       |
| PVOFFFD   | Cross-term dependence of vofffd                | _     | 0       |
| PVREC0    | Cross-term dependence of vrec0                 | _     | 0       |
| PVREC0D   | Cross-term dependence of vrec0d                | _     | 0       |
| PVSAT     | Cross-term dependence of vsat                  | _     | 0       |
| PVSCE     | Cross-term dependence of vsce                  | _     | 0       |
| PVSDFB    | Cross-term dependence of vsdfb                 | _     | 0       |
| PVSDTH    | Cross-term dependence of vsdth                 | _     | 0       |
| PVTH0     | Cross-term dependence of vto                   | _     | 0       |
| PVTUN0    | Cross-term dependence of vtun0                 | _     | 0       |
| PVTUN0D   | Cross-term dependence of vtun0d                | _     | 0       |
| PW0       | Cross-term dependence of w0                    | _     | 0       |
| PWR       | Cross-term dependence of wr                    |       | 0       |
| PXBJT     | Cross-term dependence of xbjt                  | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| PXDIF     | Cross-term dependence of xdif                                |       | 0       |
| PXDIFD    | Cross-term dependence of xdifd                               | _     | 0       |
| PXJ       | Cross-term dependence of xj                                  | _     | 0       |
| PXRCRG1   | Cross-term dependence of xrcrg1                              | _     | 0       |
| PXRCRG2   | Cross-term dependence of xrcrg2                              | _     | 0       |
| PXREC     | Cross-term dependence of xrec                                | _     | 0       |
| PXRECD    | Cross-term dependence of xrecd                               | _     | 0       |
| PXTUN     | Cross-term dependence of xtun                                | _     | 0       |
| PXTUND    | Cross-term dependence of xtund                               | _     | 0       |
| RBDB      | Body resistance  | _     | 50      |
| RBODY     | Intrinsic body contact sheet resistance                      | _     | 0       |
| RBODYMOD  | Body R model selector /* v4.0                                | _     | 0       |
| RBSB      | Body resistance  | _     | 50      |
| RBSH      | Extrinsic body contact sheet resistance                      | _     | 0       |
| RDSMOD    | Bias-dependent S/D resistance model selector /* v4.0         | _     | 0       |
| RDSW      | Source-drain resistance per width                            | _     | 100     |
| RDW       | Drain resistance per width /* v4.0                           | _     | 50      |
| RDWMIN    | Drain resistance per width at hight Vg                       | _     | 0       |
| RGATEMOD  | Gate resistance model selector                               | _     | 0       |
| RGIDL     | GIDL vg parameter  | _     | 1       |
| RGISL     | GISL vg parameter  | _     | 0       |
| RHALO     | body halo sheet resistance                                   | _     | 1e+15   |
| RNOIA     | Thermal noise coefficient                                    | _     | 0.577   |
| RNOIB     | Thermal noise coefficient                                    | _     | 0.37    |
| RSH       | Source-drain sheet resistance                                | _     | 0       |
| RSHG      | Gate sheet resistance  | _     | 0.1     |
| RSW       | Source resistance per width /* v4.0                          | _     | 50      |
| RSWMIN    | Source resistance per width at high Vg                       | _     | 0       |
| RTH0      | Instance Thermal Resistance                                  | _     | 0       |
| SA        | distance between OD edge to poly of one side                 | m     | 0       |
| SAREF     | Reference distance between OD edge to poly of one side       | m     | 1e-06   |
| SB        | distance between OD edge to poly of the other side           | m     | 0       |
| SBREF     | Reference distance between OD edge to poly of the other side | m     | 1e-06   |
| SD        | distance between neighbor fingers                            | m     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| SHMOD     | Self heating mode selector  | _     | 0        |
| SIIO      | First Vgs dependent parameter for impact ionization current                       | _     | 0.5      |
| SII1      | Second Vgs dependent parameter for impact ionization current                      |       | 0.1      |
| SII2      | Third Vgs dependent parameter for impact ionization current                       | _     | 0        |
| SIID      | Vds dependent parameter of drain saturation voltage for impact ionization current | —     | 0        |
| SOIMOD    | Instance model selector for PD/FD operation /* v3.2                               | _     | 0        |
| STETA0    | eta0 shift factor related to stress effect on vth                                 | m     | 0        |
| STETA0CV  | eta0cv shift factor related to stress effect on vth                               |       | 0        |
| STK2      | K2 shift factor related to stress effect on vth                                   | m     | 0        |
| TBGASUB   | First parameter of band-gap change due to temperature                             |       | 0.000702 |
| TBGBSUB   | Second parameter of band-gap change due to temperature                            |       | 1108     |
| TBOX      | Back gate oxide thickness in meters   | m     | 3e-07    |
| TCJSWG    | Temperature coefficient of Cjswgs   | 1/K   | 0        |
| TCJSWGD   | Temperature coefficient of Cjswgd   | 1/K   | 0        |
| TEMPEOT   | Temperature for extraction of EOT   | K     | 300.15   |
| TII       | Temperature dependent parameter for impact ionization                             | _     | 0        |
| TKU0      | Temperature coefficient of KU0  | _     | 0        |
| TNOIA     | Thermal noise parameter   | _     | 1.5      |
| TNOIB     | Thermal noise parameter   | _     | 3.5      |
| TNOIMOD   | Thermal noise model selector  | _     | 0        |
| TNOM      | Parameter measurement temperature   | _     | 27       |
| TOX       | Gate oxide thickness in meters  | m     | 1e-08    |
| TOXM      | Gate oxide thickness used in extraction /* v3.2                                   | m     | 0        |
| TOXP      | Physical gate oxide thickness   | m     | 0        |
| TOXQM     | effective oxide thickness considering quantum effect                              | m     | 0        |
| TOXREF    | target oxide thickness  | m     | 2.5e-09  |
| TPBSWG    | Temperature coefficient of Pbswgs   | V/K   | 0        |
| TPBSWGD   | Temperature coefficient of Pbswgd   | V/K   | 0        |
| TSI       | Silicon-on-insulator thickness in meters  | m     | 1e-07    |
| TT        | Diffusion capacitance transit time coefficient                                    | s     | 1e-12    |
| TVBCI     | Temperature coefficient for VBCI  | _     | 0        |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description   | Units | Default   |
|-----------|---|-------|-----------|
| TYPE      | +1 = NMOS, -1 = PMOS  | _     | 1         |
| U0        | Low-field mobility at Tnom  | _     | 0         |
| UA        | Linear gate dependence of mobility  | _     | 2.25e-09  |
| UA1       | Temperature coefficient of ua   | m/V   | 4.31e-09  |
| UB        | Quadratic gate dependence of mobility                                       | _     | 5.87e-19  |
| UB1       | Temperature coefficient of ub   | _     | -7.61e-18 |
| UC        | Body-bias dependence of mobility  |       | 0         |
| UC1       | Temperature coefficient of uc   | _     | 0         |
| UCS       | Mobility exponent   | _     | 0         |
| UCSTE     | Temperature coefficient of UCS  | _     | -0.004775 |
| UD        | Coulomb scattering factor of mobility                                       | _     | 0         |
| UD1       | Temperature coefficient of ud   | _     | 0         |
| UTE       | Temperature coefficient of mobility   | _     | -1.5      |
| VABJT     | Early voltage for bipolar current   | V     | 10        |
| VBCI      | Internal B-C built-in potential   | V     | 0         |
| VBM       | Maximum body voltage  | V     | -3        |
| VBS0FD    | Lower bound of built-in potential lowering for FD operation /* v3.2         | V     | 0.5       |
| VBS0PD    | Upper bound of built-in potential lowering for PD operation /* v3.2         | V     | 0         |
| VBSA      | vbsa offset voltage   | V     | 0         |
| VBSUSR    | Vbs specified by user   | V     | 0         |
| VBX       | Vth transition body Voltage   | _     | 0         |
| VDDEOT    | Voltage for extraction of EOT   | _     | 0         |
| VDSATII0  | Nominal drain saturation voltage at threshold for impact ionization current | _     | 0.9       |
| VECB      | Vaux parameter for conduction-band electron tunneling                       | _     | 0.026     |
| VERSION   | parameter for model version   | _     | 4.6       |
| VEVB      | Vaux parameter for valence-band electron tunneling                          | _     | 0.075     |
| VFB       | Flat Band Voltage /* v4.1   | V     | -1        |
| VGB1      | Third Vox dependent parameter for gate current in inversion                 | V     | 300       |
| VGB2      | Third Vox dependent parameter for gate current in accumulation              | V     | 17        |
| VGSTCVMOD | Improved VgsteffCV selector   | _     | 0         |
| VOFF      | Threshold voltage offset  | V     | -0.08     |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| VOFFCV    | CV Threshold voltage offset // NOT -0.08 for backwards-compatibility | V     | 0       |
| VOFFFD    | smoothing parameter in FD module                                     | V     | 0       |
| VOXH      | the limit of Vox in gate current calculation                         | V     | 5       |
| VREC0     | Voltage dependent parameter for recombination current                | V     | 0       |
| VREC0D    | Voltage dependent parameter for recombination current                | V     | 0       |
| VSAT      | Saturation velocity at tnom  | _     | 80000   |
| VSCE      | SCE parameter for improved dVbi model                                | _     | 0       |
| VSDFB     | Source/drain bottom diffusion capacitance flatband voltage           | V     | 0       |
| VSDTH     | Source/drain bottom diffusion capacitance threshold voltage          | V     | 0       |
| VTH0      | Threshold voltage  | V     | 0       |
| VTHO      | Threshold voltage  | V     | 0       |
| VTM00     | Hard coded 25 degC thermal voltage                                   | V     | 0.026   |
| VTUN0     | Voltage dependent parameter for tunneling current                    | V     | 0       |
| VTUN0D    | Voltage dependent parameter for tunneling current                    | V     | 0       |
| W         | Width  | m     | 5e-06   |
| W0        | Narrow width effect parameter  | m     | 2.5e-06 |
| WOFLK     | Flicker noise width dependence                                       | _     | 1e-05   |
| WA0       | Width dependence of a0   | _     | 0       |
| WA1       | Width dependence of a1   | _     | 0       |
| WA2       | Width dependence of a2   | _     | 0       |
| WABJTII   | Width dependence of abjtii   | _     | 0       |
| WACDE     | Width dependence of acde   |       | 0       |
| WAELY     | Width dependence of aely   | _     | 0       |
| WAGIDL    | Width dependence of agidl  |       | 0       |
| WAGISL    | Width dependence of agisl  |       | 0       |
| WAGS      | Width dependence of ags  | _     | 0       |
| WAHLI     | Width dependence of ahli /* v4.0                                     | _     | 0       |
| WAHLID    | Width dependence of ahlid /* v4.0                                    | _     | 0       |
| WAIGBCP2  | Width dependence of aigbcp2  | _     | 0       |
| WAIGC     | Width dependence of aigc   | _     | 0       |
| WAIGSD    | Width dependence of aigsd  | _     | 0       |
| WALPHA0   | Width dependence of alpha0   | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                  | Units | Default |
|-----------|------------------------------|-------|---------|
| WALPHAGB1 | Width dependence of alphagb1 |       | 0       |
| WALPHAGB2 | Width dependence of alphagb2 | _     | 0       |
| WAT       | Width dependence of at       | _     | 0       |
| WB0       | Width dependence of b0       | _     | 0       |
| WB1       | Width dependence of b1       | _     | 0       |
| WBETA0    | Width dependence of beta0    | _     | 0       |
| WBETA1    | Width dependence of beta1    | _     | 0       |
| WBETA2    | Width dependence of beta2    | _     | 0       |
| WBETAGB1  | Width dependence of betagb1  | _     | 0       |
| WBETAGB2  | Width dependence of betagb2  |       | 0       |
| WBGIDL    | Width dependence of bgidl    | _     | 0       |
| WBGISL    | Width dependence of bgisl    |       | 0       |
| WBIGBCP2  | Width dependence of bigbcp2  | _     | 0       |
| WBIGC     | Width dependence of bigc     | _     | 0       |
| WBIGSD    | Width dependence of bigsd    | _     | 0       |
| WCBJTII   | Width dependence of cbjtii   | _     | 0       |
| WCDSBS    | Width dependence of cdsbs    |       | 0       |
| WCDSC     | Width dependence of cdsc     | _     | 0       |
| WCDSCB    | Width dependence of cdscb    |       | 0       |
| WCDSCD    | Width dependence of cdscd    | _     | 0       |
| WCGDL     | Width dependence of cgdl     | _     | 0       |
| WCGIDL    | Width dependence of cgidl    | _     | 0       |
| WCGISL    | Width dependence of cgisl    | _     | 0       |
| WCGSL     | Width dependence of cgsl     | _     | 0       |
| WCIGBCP2  | Width dependence of cigbcp2  | _     | 0       |
| WCIGC     | Width dependence of cigc     | _     | 0       |
| WCIGSD    | Width dependence of cigsd    | _     | 0       |
| WCIT      | Width dependence of cit      | _     | 0       |
| WCKAPPA   | Width dependence of ckappa   | _     | 0       |
| WDELTA    | Width dependence of delta    | _     | 0       |
| WDELVT    | Width dependence of delvt    | _     | 0       |
| WDK2B     | Width dependence of dk2b     | _     | 0       |
| WDROUT    | Width dependence of drout    | _     | 0       |
| WDSUB     | Width dependence of dsub     | _     | 0       |
| WDVBD0    | Width dependence of dvbd0    | _     | 0       |
| WDVBD1    | Width dependence of dvbd1    |       | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| MDVTOW         Width dependence of dvt0w         —         0           MDVT1         Width dependence of dvt1         —         0           MDVT1W         Width dependence of dvt1w         —         0           MDVT2         Width dependence of dvt2         —         0           MDVTPW         Width dependence of dvt2w         —         0           MDVTPO         Width dependence of dvtp0         —         0           MDVTP1         Width dependence of dvtp1         —         0           MDVTP2         Width dependence of dvtp2         —         0           MDVTP3         Width dependence of dvtp3         —         0           MDVTP4         Width dependence of dvtp4         —         0           MDWB         Width dependence of dwb         —         0           MDWG         Width dependence of edwg         —         0           WEFFDT         Effective width for extraction of EOT         —         10           WEFGIDL         Width dependence of egidl         —         0           WEFATI         Width dependence of egisl         —         0           WETAOCV         Width dependence of eta0         —         0           WETAB         Width depende   | Parameter | Description                           | Units | Default |
|--|-----------|---------------------------------------|-------|---------|
| WDVT1         Width dependence of dvt1w         —         0           WDVT2         Width dependence of dvt2w         —         0           WDVT2W         Width dependence of dvt2w         —         0           WDVTP0         Width dependence of dvtp0         —         0           WDVTP1         Width dependence of dvtp1         —         0           WDVTP2         Width dependence of dvtp2         —         0           WDVTP3         Width dependence of dvtp3         —         0           WDVTP4         Width dependence of dvtp4         —         0           WDWB         Width dependence of dwg         —         0           WDWG         Width dependence of dwg         —         0           WEBJII         Width dependence of egidl         —         0           WEGIDL         Width dependence of egidl         —         0           WEGISL         Width dependence of egidl         —         0           WETAO         Width dependence of etabl         —         0           WETAO         Width dependence of etabl         —         0           WETABCV         Width dependence of etabl         —         0           WETABCV         Width dependence of figid   | WDVT0     | Width dependence of dvt0              |       | 0       |
| WDVT1W         Width dependence of dvt1w         —         0           WDVT2         Width dependence of dvt2w         —         0           WDVT2W         Width dependence of dvtp0         —         0           MDVTP1         Width dependence of dvtp1         —         0           MDVTP2         Width dependence of dvtp2         —         0           MDVTP3         Width dependence of dvtp3         —         0           MDVTP4         Width dependence of dvtp4         —         0           WDWB         Width dependence of dwb         —         0           WDWB         Width dependence of dwg         —         0           WEALTII         Width dependence of edwg         —         0           WEGIDL         Width dependence of egidl         —         0           WEGISL         Width dependence of egidl         —         0           WETAO         Width dependence of egidl         —         0           WETAO         Width dependence of eta0         —         0           WETAB         Width dependence of eta0         —         0           WETAB         Width dependence of etabev         —         0           WED         Width dependence of feta0  | WDVT0W    | Width dependence of dvt0w             | _     | 0       |
| WDVT2         Width dependence of dvt2w         —         0           WDVT2W         Width dependence of dvtp0         —         0           WDVTP0         Width dependence of dvtp0         —         0           WDVTP1         Width dependence of dvtp1         —         0           WDVTP2         Width dependence of dvtp2         —         0           WDVTP3         Width dependence of dvtp4         —         0           WDWB         Width dependence of dvtp4         —         0           WDWB         Width dependence of dwb         —         0           WDWG         Width dependence of dwg         —         0           WDWG         Width dependence of ebitii         —         0           WEFFDT         Effective width for extraction of EOT         —         10           WEGIDL         Width dependence of egidl         —         0           WEGISL         Width dependence of egidl         —         0           WESATII         Width dependence of egidl         —         0           WETA0CV         Width dependence of eta0         —         0           WETAB         Width dependence of etabev         —         0           WETAB         Width dependen   | WDVT1     | Width dependence of dvt1              | _     | 0       |
| WDVT2W Width dependence of dvt2W — 0 WDVTP0 Width dependence of dvtp0 — 0 WDVTP1 Width dependence of dvtp1 — 0 WDVTP2 Width dependence of dvtp2 — 0 WDVTP3 Width dependence of dvtp3 — 0 WDVTP4 Width dependence of dvtp4 — 0 WDWB Width dependence of dvtp4 — 0 WDWB Width dependence of dvtp4 — 0 WDWB Width dependence of dwtp4 — 0 WDWB Width dependence of dwtp4 — 0 WEBJIII Width dependence of dwg — 0 WEBJIII Width dependence of edgl — 0 WEGISL Width dependence of egidl — 0 WEGISL Width dependence of egisl — 0 WETAO Width dependence of eato — 0 WETAO Width dependence of etaOv — 0 WETAB Width dependence of etaOv — 0 WETABCV Width dependence of etaOv — 0 WED WIDTI Width dependence of etaOv — 0 WED WIDTI Width dependence of etaOv — 0 WED WIDTI Width dependence of etaOv — 0 WEGISL Width dependence of etaOv — 0 WEGISL Width dependence of etaOv — 0 WEGISL Width dependence of figil — 0 WIDDIF WIDDIF Width dependence of figil — 0 WIDDIF WIDDIF Width dependence of idifi — 0 WIDDIF Width dependence of idifi — 0 WIDDIF Width dependence of idific —  | WDVT1W    | Width dependence of dvt1w             | _     | 0       |
| WDVTPO Width dependence of dvtpO — 0 WDVTP1 Width dependence of dvtp1 — 0 WDVTP2 Width dependence of dvtp2 — 0 WDVTP3 Width dependence of dvtp3 — 0 WDVTP4 Width dependence of dvtp4 — 0 WDWB Width dependence of dwb — 0 WDWB Width dependence of dwb — 0 WEBJTII Width dependence of dwg — 0 WEGISL Width dependence of egisl — 0 WEGIAC Width dependence of egisl — 0 WETAB Width dependence of etab — 0 WED WITH WIDTH WIDTH — 0 WETAB WIDTH WIDTH — 0 WETAB WIDTH WIDTH — 0 WEFICL WIDTH WIDTH — 0 WEFICL WIDTH WIDTH — 0 WITH WIDDLY WIDTH — 0 WIDDLY WIDTH WIDTH — 0 WIDDLY WIDTH WIDTH — 0 WIDDLY WIDTH WIDTH — 0 WIDTH WIDTH WIDTH — 0 WIDTH WIDTH WIDTH — 0 WISTBJT — 0  | WDVT2     | Width dependence of dvt2              | _     | 0       |
| WDVTP1 Width dependence of dvtp1 — 0 WDVTP2 Width dependence of dvtp2 — 0 WDVTP3 Width dependence of dvtp3 — 0 WDVTP4 Width dependence of dvtp4 — 0 WDWB Width dependence of dvtp4 — 0 WDWB Width dependence of dwb — 0 WDWB Width dependence of dwb — 0 WEBJIII Width dependence of ebjtii — 0 WEFFEOT Effective width for extraction of EOT — 10 WEGIDL Width dependence of egill — 0 WESATII Width dependence of egil — 0 WETAO Width dependence of etaO — 0 WETAO Width dependence of etaO — 0 WETAE Width dependence of etaO — 0 WETABE Width dependence of etab — 0 WETABE Width dependence of etab — 0 WETABL Width dependence of etab — 0 WEFJIII Width dependence of etab — 0 WEFJIII Width dependence of etab — 0 WEFGISL Width dependence of figil — 0 WIFFROUT Width dependence of figil — 0 WIFFROUT Width dependence of idibit — 0 WIDDIF Width dependence of idibit — 0 WIDDIF Width dependence of idibit — 0 WIDDIF Width dependence of iditur — 0 WIDDIF Width dependence of iditur — 0 WISDIF Width dependence of iditur — 0 WISDIT Width dependence of iditur — 0 WISDIT Width dependence of iditur — 0 WISDIF Width dependence of iditif — 0   | WDVT2W    | Width dependence of dvt2w             | _     | 0       |
| WDVTP2 Width dependence of dvtp2 — 0 WDVTP3 Width dependence of dvtp3 — 0 WDVTP4 Width dependence of dvtp4 — 0 WDWB Width dependence of dvtp4 — 0 WDWB Width dependence of dwb — 0 WDWG Width dependence of dwg — 0 WEBJTII Width dependence of ebitii — 0 WEGIDL Width dependence of egidl — 0 WEGISL Width dependence of egisl — 0 WETAO Width dependence of eastii — 0 WETAO Width dependence of etaO — 0 WETAB Width dependence of etaO — 0 WETAB Width dependence of etab — 0 WETABL Width dependence of etab — 0 WED WETABL Width dependence of etab — 0 WED WIDTII Width dependence of etab — 0 WFBJTII Width dependence of etab — 0 WFBJTII Width dependence of etab — 0 WFGISL Width dependence of figil — 0 WFGISL Width dependence of figil — 0 WFGISL Width dependence of idipt — 0 WIDDIF Width dependence of idipt — 0 WIDTUN Width dependence of iditun — 0 WINT Width dependence of iditun — 0 WISSDIF Width dependence of isbjt — 0  | WDVTP0    | Width dependence of dvtp0             | _     | 0       |
| WDVTP3 Width dependence of dvtp3 — 0 WDVTP4 Width dependence of dvtp4 — 0 WDWB Width dependence of dwb — 0 WDWG Width dependence of dwg — 0 WEBJTII Width dependence of ebjtii — 0 WEFFEOT Effective width for extraction of EOT — 10 WEGIDL Width dependence of egidl — 0 WESATII Width dependence of egisl — 0 WETAO Width dependence of etaO — 0 WETAO Width dependence of etaO — 0 WETAB Width dependence of etaOv — 0 WETAB Width dependence of etaOv — 0 WETAB Width dependence of etaDv — 0 WETAB Width dependence of etaDv — 0 WETAB Width dependence of etaDv — 0 WETAB Width dependence of fetaDv — 0 WEU Width dependence of etaDv — 0 WEDJIII Width dependence of fetaDv — 0 WEFBJTII Width dependence of figtil — 0 WFGISL Width dependence of figtil — 0 WFGISL Width dependence of figtil — 0 WFFROOT Width dependence of figtil — 0 WIDDIT Width dependence of idbjt — 0 WIDDIT Width dependence of idbjt — 0 WIDDIF Width dependence of ididif — 0 WIDDIF Width dependence of ididif — 0 WIDTUN Width dependence of ididin — 0 WINT Width dependence of ididin — 0 WISSDIT Width dependence of ididif — 0 WISSDIF Width dependence of ididif — 0  | WDVTP1    | Width dependence of dvtp1             | _     | 0       |
| WDVTP4 Width dependence of dvtp4 — 0 WDWB Width dependence of dwb — 0 WDWG Width dependence of dwg — 0 WEBJTII Width dependence of ebjtii — 0 WEFFEOT Effective width for extraction of EOT — 10 WEGIDL Width dependence of egidl — 0 WESATII Width dependence of egisl — 0 WETAO Width dependence of eta0 — 0 WETAO Width dependence of eta0 — 0 WETAB Width dependence of etabev — 0 WETAB Width dependence of etabev — 0 WETAB Width dependence of etabev — 0 WETABL Width dependence of etabov — 0 WETABL Width dependence of figill — 0 WFGIDL Width dependence of figill — 0 WFFGIDL Width dependence of figill — 0 WFFROUT Width dependence of figill — 0 WIDDIF Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTON WIGHT Width dependence of iddif — 0 WINT Width reduction parameter — 0 WISBJT Width dependence of isbjt — 0   | WDVTP2    | Width dependence of dvtp2             | _     | 0       |
| WDWB Width dependence of dwb — 0 WDWG Width dependence of dwg — 0 WEBJTII Width dependence of ebjtii — 0 WEFFEOT Effective width for extraction of EOT — 10 WEGIDL Width dependence of egidl — 0 WEGISL Width dependence of egisl — 0 WESATII Width dependence of esatii — 0 WETAO Width dependence of etaO — 0 WETAO Width dependence of etaO — 0 WETAB Width dependence of etaO — 0 WETAB Width dependence of etaO — 0 WETAB Width dependence of etab — 0 WETAB Width dependence of etab — 0 WEY WIDTH WIDTH DEPENDENCE OF ETABLEY | WDVTP3    | Width dependence of dvtp3             | _     | 0       |
| WDWG Width dependence of dwg — 0 WEBJTII Width dependence of ebjtii — 0 WEFFEOT Effective width for extraction of EOT — 10 WEGIDL Width dependence of egidl — 0 WEGISL Width dependence of egisl — 0 WESATII Width dependence of esatii — 0 WETAO WETAO Width dependence of etaO — 0 WETAOCV Width dependence of etaO — 0 WETAB Width dependence of etab — 0 WETABCV Width dependence of etab — 0 WETABCV Width dependence of etabcv — 0 WFBJIII Width dependence of figial — 0 WFGISL Width dependence of figial — 0 WFGISL Width dependence of figisl — 0 WIDDIF Width dependence of idbjt — 0 WIDDIF Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTUN Width dependence of idun — 0 WINT Width reduction parameter — 0 WISBJT Width dependence of isbjt — 0  | WDVTP4    | Width dependence of dvtp4             | _     | 0       |
| WEBJTII Width dependence of ebjtii — 0 WEFFEOT Effective width for extraction of EOT — 10 WEGIDL Width dependence of egidl — 0 WEGISL Width dependence of egisl — 0 WESATII Width dependence of esatii — 0 WETAO WETAO Width dependence of etaOcv — 0 WETAB Width dependence of etaOcv — 0 WETAB Width dependence of etabov — 0 WETABCV Width dependence of etabov — 0 WETABCV Width dependence of etabov — 0 WEU Width dependence of etabov — 0 WEGISL Width dependence of etabov — 0 WFBJTII Width dependence of figitl — 0 WFGISL Width dependence of figitl — 0 WFGISL Width dependence of figitl — 0 WIDDIF Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTUN Width dependence of idrec — 0 WIDTUN Width dependence of idun — 0 WISBJT Width dependence of isbjt — 0  | WDWB      | Width dependence of dwb               |       | 0       |
| WEFFEOT       Effective width for extraction of EOT       —       10         WEGIDL       Width dependence of egidl       —       0         WEGISL       Width dependence of egisl       —       0         WESATII       Width dependence of esatii       —       0         WETAO       Width dependence of etaOcv       —       0         WETAOCV       Width dependence of etaDcv       —       0         WETAB       Width dependence of etabcv       —       0         WEU       Width dependence of eu       —       0         WFBJTII       Width dependence of fgidl       —       0         WFGIDL       Width dependence of fgidl       —       0         WFGISL       Width dependence of fgisl       —       0         WFFROUT       Width dependence of jtblicb       —       0         WIDDJT       Width dependence of idbjt       —       0         WIDDJT       Width dependence of iddif       —       0         WIDDLE       Width dependence of idec       —       0         WIDDLE       Width dependence of idec       —       0         WIDDLE       Width dependence of idec       —       0         WIDDLE       Width de  | WDWG      | Width dependence of dwg               |       | 0       |
| WEGIDL Width dependence of egisl — 0 WEGISL Width dependence of egisl — 0 WESATII Width dependence of esatii — 0 WETAO WIDTH OF THE PROPERTY O | WEBJTII   | Width dependence of ebjtii            |       | 0       |
| WEGISL Width dependence of egisl — 0 WESATII Width dependence of esatii — 0 WETAO Width dependence of etaO — 0 WETAOCV Width dependence of etaOcv — 0 WETAB Width dependence of etab — 0 WETABCV Width dependence of etabcv — 0 WEU Width dependence of etabcv — 0 WEU Width dependence of eta U — 0 WEBJIII Width dependence of figitl — 0 WEGISL Width dependence of figitl — 0 WEGISL Width dependence of figisl — 0 WEFROUT Width dependence of publicb — 0 WIDDJT Width dependence of idbjt — 0 WIDDJF Width dependence of iddif — 0 WIDDLE Width dependence of iddif — 0 WIDTON WIDTON Width dependence of iddif — 0 WIDTON WIDTON Width dependence of idun — 0 WISTEC Width dependence of isbjt — 0 WISSBJT Width dependence of isbjt — 0 WISSBJT Width dependence of isbjt — 0 WISSBJT Width dependence of isbjt — 0 WISSBJF Width dependence of isbjt — 0   | WEFFEOT   | Effective width for extraction of EOT |       | 10      |
| WESATII Width dependence of esatii — 0 WETAO Width dependence of etaO — 0 WETAOCV Width dependence of etaOcv — 0 WETAB Width dependence of etab — 0 WETABCV Width dependence of etab — 0 WETABCV Width dependence of etabcv — 0 WEU Width dependence of eu — 0 WEGIDL Width dependence of fbitii — 0 WEGIDL Width dependence of fgidl — 0 WEGISL Width dependence of fgisl — 0 WEFROUT Width dependence of pdiblcb — 0 WIDDJT WIDDJT Width dependence of idbjt — 0 WIDDJF WIDDLE Width dependence of iddif — 0 WIDTEC Width dependence of idrec — 0 WIDTUN WIDTEN Width dependence of idtun — 0 WINT Width dependence of idtun — 0 WISSBJT Width dependence of isbjt — 0 WISSBJT Width dependence of isbjt — 0 WISSDJF Width dependence of isidif — 0 WISSDJF Width dependence of isidif — 0 WISSDJF Width dependence of isidif — 0 WISSBCC Width dependence of isidif — 0   | WEGIDL    | Width dependence of egidl             | _     | 0       |
| WETAO Width dependence of etaOcv — 0 WETAOCV Width dependence of etaOcv — 0 WETAB Width dependence of etab — 0 WETABCV Width dependence of etabcv — 0 WEU Width dependence of eu — 0 WFBJTII Width dependence of bjtii — 0 WFGIDL Width dependence of fgidl — 0 WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdiblob — 0 WIDDJT Width dependence of idbjt — 0 WIDDJF Width dependence of iddif — 0 WIDDLEC Width dependence of iddif — 0 WIDTUN Width dependence of idun — 0 WINT Width dependence of idun — 0 WISBJT Width dependence of isbjt — 0 WISDJT Width dependence of idun — 0 WISTJT Width dependence of idun — 0 WISTJT Width dependence of isbjt — 0 WISDJT Width dependence of isbjt — 0 WISDJT Width dependence of isbjt — 0 WISDJT Width dependence of isbjt — 0 WISDJF Width dependence of isbjt — 0  | WEGISL    | Width dependence of egisl             | _     | 0       |
| WETAOCV Width dependence of etaOcv WETAB Width dependence of etab  Width dependence of etabcv Width dependence of etabcv WEU Width dependence of eu WEGIDL WEGIDL Width dependence of fgidl Width dependence of fgidl Width dependence of fgisl Width dependence of fgisl Width dependence of pdiblcb WIDDIT WIDDIT Width dependence of idbjt Width dependence of iddif WIDDIF | WESATII   | Width dependence of esatii            | _     | 0       |
| WETAB Width dependence of etabev — 0 WETABCV Width dependence of etabev — 0 WEU Width dependence of eu — 0 WFBJTII Width dependence of fbjtii — 0 WFGIDL Width dependence of fgidl — 0 WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdibleb — 0 WIDDJT Width dependence of idbjt — 0 WIDDJF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTUN Width dependence of idun — 0 WINT Width dependence of idun — 0 WISBJT Width dependence of isbjt — 0 WISDJF Width dependence of isbjt — 0 WISDJF Width dependence of isbjt — 0 WISDJF Width dependence of isbjt — 0 WISSDJF Width dependence of isbjt — 0   | WETA0     | Width dependence of eta0              | _     | 0       |
| WETABCV Width dependence of etabcv — 0 WEU Width dependence of eu — 0 WFBJTII Width dependence of fbjtii — 0 WFGIDL Width dependence of fgidl — 0 WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdiblcb — 0 WIDBJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTUN Width dependence of idtun — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of iscaic — 0   | WETA0CV   | Width dependence of eta0cv            | _     | 0       |
| WEU Width dependence of eu — 0 WFBJTII Width dependence of fbjtii — 0 WFGIDL Width dependence of fgidl — 0 WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdiblcb — 0 WIDBJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTUN Width dependence of idtun — 0 WIDTUN Width dependence of idtun — 0 WISBJT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isbjt — 0 WISSBJT Width dependence of isdif — 0 WISDIF Width dependence of isdif — 0 WISDIF Width dependence of isdif — 0 WISSBJT Width dependence of isdif — 0 WISSBJT Width dependence of isdif — 0  | WETAB     | Width dependence of etab              | _     | 0       |
| WFBJTII Width dependence of fbjtii — 0 WFGIDL Width dependence of fgidl — 0 WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdiblcb — 0 WIDBJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDDIF Width dependence of iddif — 0 WIDTUN Width dependence of idtun — 0 WINT Width dependence of idtun — 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isdif — 0 WISDIF Width dependence of isdif — 0 WISDIF Width dependence of isdif — 0 WISDIF Width dependence of isdif — 0 WISSEC Width dependence of isrec — 0   | WETABCV   | Width dependence of etabcv            | _     | 0       |
| WFGIDL Width dependence of fgidl — 0 WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdiblcb — 0 WIDBJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDREC Width dependence of idrec — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isdif — 0 WISBJF Width dependence of isdif — 0 WISREC Width dependence of isdif — 0  | WEU       | Width dependence of eu                | _     | 0       |
| WFGISL Width dependence of fgisl — 0 WFPROUT Width dependence of pdibleb — 0 WIDBJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDREC Width dependence of idrec — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isdif — 0 WISREC Width dependence of isrec — 0   | WFBJTII   | Width dependence of fbjtii            | _     | 0       |
| WIPROUT Width dependence of pdibleb — 0 WIDDJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDREC Width dependence of idrec — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISDJF Width dependence of isdif — 0 WISREC Width dependence of isdif — 0 WISREC Width dependence of isrec — 0   | WFGIDL    | Width dependence of fgidl             | _     | 0       |
| WIDBJT Width dependence of idbjt — 0 WIDDIF Width dependence of iddif — 0 WIDREC Width dependence of idrec — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0  | WFGISL    | Width dependence of fgisl             | _     | 0       |
| WIDDIF Width dependence of iddif — 0 WIDREC Width dependence of idrec — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0   | WFPROUT   | Width dependence of pdiblcb           | _     | 0       |
| WIDREC Width dependence of idrec — 0 WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0  | WIDBJT    | Width dependence of idbjt             | _     | 0       |
| WIDTUN Width dependence of idtun — 0 WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0   | WIDDIF    | Width dependence of iddif             | _     | 0       |
| WINT Width reduction parameter m 0 WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0  | WIDREC    | Width dependence of idrec             | _     | 0       |
| WISBJT Width dependence of isbjt — 0 WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0   | WIDTUN    | Width dependence of idtun             | _     | 0       |
| WISDIF Width dependence of isdif — 0 WISREC Width dependence of isrec — 0  | WINT      | Width reduction parameter             | m     | 0       |
| WISREC Width dependence of isrec — 0   | WISBJT    | Width dependence of isbjt             | _     | 0       |
|  | WISDIF    | Width dependence of isdif             | _     | 0       |
| WISTUN Width dependence of istun — 0   | WISREC    | Width dependence of isrec             | _     | 0       |
|  | WISTUN    | Width dependence of istun             | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                         | Units | Default |
|-----------|-------------------------------------|-------|---------|
| WK1       | Width dependence of k1              |       | 0       |
| WK1B      | Width dependence of k1b             | _     | 0       |
| WK1W1     | Width dependence of k1w1            | _     | 0       |
| WK1W2     | Width dependence of k1w2            | _     | 0       |
| WK2       | Width dependence of k2              | _     | 0       |
| WK2B      | Width dependence of k2b             | _     | 0       |
| wK3       | Width dependence of k3              | _     | 0       |
| WK3B      | Width dependence of k3b             | _     | 0       |
| WKB1      | Width dependence of kb1             | _     | 0       |
| WKETA     | Width dependence of keta            | _     | 0       |
| WKETAS    | Width dependence of ketas           | _     | 0       |
| WKGIDL    | Width dependence of kgidl           |       | 0       |
| WKGISL    | Width dependence of kgisl           | _     | 0       |
| WKT1      | Width dependence of kt1             | _     | 0       |
| WKT1L     | Width dependence of kt11            | _     | 0       |
| WKT2      | Width dependence of kt2             | _     | 0       |
| WKU0      | Width dependence of ku0             | _     | 0       |
| WKVTHO    | Width dependence of kvth0           | _     | 0       |
| √L        | Width reduction parameter           | m     | 0       |
| WLBJT0    | Width dependence of lbjt0           | _     | 0       |
| VLC       | Width reduction parameter /* v2.2.3 | _     | 0       |
| WLII      | Width dependence of lii             | _     | 0       |
| WLN       | Width reduction parameter           | _     | 1       |
| WLOD      | Width parameter for stress effect   | m     | 0       |
| WLODKU0   | Width parameter for u0 LOD effect   | _     | 0       |
| WLODVTH   | Width parameter for vth LOD effect  | _     | 0       |
| WLPE0     | Width dependence of lpe0            | _     | 0       |
| WLPEB     | Width dependence of lpeb            | _     | 0       |
| WMBJTII   | Width dependence of mbjtii          | _     | 0       |
| WMINV     | width dependence of minv            | _     | 0       |
| WMINVCV   | width dependence of minvcv          | _     | 0       |
| WMOIN     | Width dependence of moin            | _     | 0       |
| WMOINFD   | Width dependence of moinfd          | _     | 0       |
| WNBJT     | Width dependence of nbjt            | _     | 0       |
| WNCH      | Width dependence of nch             | _     | 0       |
| WNDIF     | Width dependence of ndif            | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                       | Units | Default |
|-----------|-----------------------------------|-------|---------|
| WNDIODE   | Width dependence of ndiode        |       | 0       |
| WNDIODED  | Width dependence of ndioded       | _     | 0       |
| WNFACTOR  | Width dependence of nfactor       | _     | 0       |
| WNGATE    | Width dependence of ngate         | _     | 0       |
| WNGIDL    | Width dependence of ngidl         | _     | 0       |
| WNIGC     | Width dependence of nigc          | _     | 0       |
| WNLX      | Width dependence of nlx           | _     | 0       |
| WNOFF     | Width dependence of noff /* v3.2  | _     | 0       |
| WNOFF2    | Width dependence of noff2 /* v4.6 | _     | 0       |
| WNOFFFD   | Width dependence of nofffd        | _     | 0       |
| WNRECF0   | Width dependence of nrecf0        | _     | 0       |
| WNRECF0D  | Width dependence of nrecf0d       |       | 0       |
| WNRECRO   | Width dependence of nrecr0        | _     | 0       |
| WNRECROD  | Width dependence of nrecr0d       | _     | 0       |
| WNSD      | Width dependence of nsd           | _     | 0       |
| NNSUB     | Width dependence of nsub          | _     | 0       |
| NTRECF    | Width dependence of ntrecf        | _     | 0       |
| NTRECR    | Width dependence of ntrecr        | _     | 0       |
| WNTUN     | Width dependence of ntun          | _     | 0       |
| WNTUND    | Width dependence of ntund         | _     | 0       |
| WPCLM     | Width dependence of pclm          | _     | 0       |
| WPDIBLC1  | Width dependence of pdiblc1       |       | 0       |
| VPDIBLC2  | Width dependence of pdiblc2       | _     | 0       |
| WPDIBLCB  | Width dependence of pdiblcb       | _     | 0       |
| WPDITS    | Width dependence of pdits         |       | 0       |
| WPDITSD   | Width dependence of pditsd        | _     | 0       |
| NP IGCD   | Width dependence for pigcd        |       | 0       |
| VPOXEDGE  | Width dependence for poxedge      |       | 0       |
| WPRT      | Width dependence of prt           |       | 0       |
| VPRWB     | Width dependence of prwb          |       | 0       |
| VPRWG     | Width dependence of prwg          |       | 0       |
| VPVAG     | Width dependence of pvag          |       | 0       |
| √R        | Width dependence of rds           |       | 1       |
| WRDSW     | Width dependence of rdsw          | _     | 0       |
| VRDW      | Width dependence of rdw /* v4.0   | _     | 0       |
| WRGIDL    | Width dependence of rgidl         | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                                      | Units | Default |
|-----------|--|-------|---------|
| WRGISL    | Width dependence of rgisl                        | _     | 0       |
| WRSW      | Width dependence of rsw /* v4.0                  |       | 0       |
| WSIIO     | Width dependence of sii0                         | _     | 0       |
| WSII1     | Width dependence of sii1                         | _     | 0       |
| WSII2     | Width dependence of sii2                         | _     | 0       |
| WSIID     | Width dependence of siid                         | _     | 0       |
| WTH0      | Minimum width for thermal resistance calculation | m     | 0       |
| WU0       | Width dependence of u0                           | _     | 0       |
| WUA       | Width dependence of ua                           | _     | 0       |
| WUA1      | Width dependence of ua1                          | _     | 0       |
| WUB       | Width dependence of ub                           |       | 0       |
| WUB1      | Width dependence of ub1                          |       | 0       |
| WUC       | Width dependence of uc                           | _     | 0       |
| WUC1      | Width dependence of uc1                          | _     | 0       |
| WUCS      | Width dependence of ucs                          | _     | 0       |
| WUCSTE    | Width dependence of ucste                        | _     | 0       |
| WUD       | Width dependence of ud                           | _     | 0       |
| WUD1      | Width dependence of ud1                          | _     | 0       |
| WUTE      | Width dependence of ute                          | _     | 0       |
| WVABJT    | Width dependence of vabjt                        | _     | 0       |
| WVBCI     | Width dependence of vbci                         | _     | 0       |
| WVBS0FD   | Width dependence of vbs0fd                       | _     | 0       |
| WVBS0PD   | Width dependence of vbs0pd                       | _     | 0       |
| WVBSA     | Width dependence of vbsa                         | _     | 0       |
| WVDSATII0 | Width dependence of vdsatii0                     | _     | 0       |
| WVFB      | Width dependence of vfb /* v4.1                  | _     | 0       |
| WVOFF     | Width dependence of voff                         | _     | 0       |
| WVOFFCV   | Width dependence of voffcv                       | _     | 0       |
| WVOFFFD   | Width dependence of vofffd                       | _     | 0       |
| WVREC0    | Width dependence of vrec0                        | _     | 0       |
| WVREC0D   | Width dependence of vrec0d                       | _     | 0       |
| WVSAT     | Width dependence of vsat                         | _     | 0       |
| WVSCE     | Width dependence of vsce                         | _     | 0       |
| WVSDFB    | Width dependence of vsdfb                        | _     | 0       |
| WVSDTH    | Width dependence of vsdth                        | _     | 0       |
| WVTH0     | Width dependence of vto                          | _     | 0       |

Table 2-107. BSIM-SOI 4.6.1 Device Model Parameters

| Parameter | Description                                      | Units | Default  |
|-----------|--|-------|----------|
| WVTUN0    | Width dependence of vtun0                        | _     | 0        |
| WVTUNOD   | Width dependence of vtun0d                       | _     | 0        |
| WW        | Width reduction parameter                        | m     | 0        |
| WWO       | Width dependence of w0                           | _     | 0        |
| WWC       | Width reduction parameter /* v2.2.3              | _     | 0        |
| WWL       | Width reduction parameter                        | m     | 0        |
| WWLC      | Width reduction parameter /* v2.2.3              | _     | 0        |
| WWN       | Width reduction parameter                        | _     | 1        |
| WWR       | Width dependence of wr                           | _     | 0        |
| WXBJT     | Width dependence of xbjt                         | _     | 0        |
| WXDIF     | Width dependence of xdif                         | _     | 0        |
| WXDIFD    | Width dependence of xdifd                        | _     | 0        |
| WXJ       | Width dependence of xj                           | _     | 0        |
| WXRCRG1   | Width dependence of xrcrg1                       | _     | 0        |
| WXRCRG2   | Width dependence of xrcrg2                       | _     | 0        |
| WXREC     | Width dependence of xrec                         | _     | 0        |
| WXRECD    | Width dependence of xrecd                        | _     | 0        |
| WXTUN     | Width dependence of xtun                         | _     | 0        |
| WXTUND    | Width dependence of xtund                        | _     | 0        |
| XBJT      | Temperature coefficient for Isbjt                | _     | 1        |
| XDIF      | Temperature coefficient for Isdif                | _     | 0        |
| XDIFD     | Temperature coefficient for Iddif                | _     | 0        |
| XGL       | Variation in Ldrawn                              | m     | 0        |
| XGW       | Distance from gate contact center to device edge | m     | 0        |
| XJ        | Junction Depth                                   | m     | 0        |
| XPART     | Channel charge partitioning                      | _     | 0        |
| XRCRG1    | First fitting parameter the bias-dependent Rg    | _     | 12       |
| XRCRG2    | Second fitting parameter the bias-dependent Rg   | _     | 1        |
| XREC      | Temperature coefficient for Isrec                | _     | 1        |
| XRECD     | Temperature coefficient for Idrec                | _     | 0        |
| XT        | Doping depth                                     | m     | 1.55e-07 |
| XTUN      | Temperature coefficient for Istun                | _     | 0        |
| XTUND     | Temperature coefficient for Idtun                | _     | 0        |

Table 2-108. MOSFET level 70 Output Variables

| Parameter  | Description            | Units | Default |
|------------|------------------------|-------|---------|
| VDSAT      |                        | V     | none    |
| VTH        | Threshold Voltage      | V     | none    |
| IDS        | Drain-Source current   | A     | none    |
| GM         |                        | mho   | none    |
| GDS        |                        | mho   | none    |
| GMBS       |                        | mho   | none    |
| IC         | Collector Current      | A     | none    |
| IBD        |                        | A     | none    |
| IBS        |                        | A     | none    |
| IGIDL      |                        | A     | none    |
| IGISL      |                        | A     | none    |
| IGS        |                        | A     | none    |
| IGD        |                        | A     | none    |
| IGB        |                        | A     | none    |
| IGCS       |                        | A     | none    |
| IGCD       |                        | A     | none    |
| CGG        | g-g MOSFET capacitance | F     | none    |
| CGS        | g-s MOSFET capacitance | F     | none    |
| CGD        | g-d MOSFET capacitance | F     | none    |
| CBG        | b-g MOSFET capacitance | F     | none    |
| CBS        | b-s MOSFET capacitance | F     | none    |
| CBD        | b-d MOSFET capacitance | F     | none    |
| CDG        | d-g MOSFET capacitance | F     | none    |
| CDD        | d-d MOSFET capacitance | F     | none    |
| CDS        | d-s MOSFET capacitance | F     | none    |
| CAPBD      | MOSFET capacitance     | F     | none    |
| CAPBS      | MOSFET capacitance     | F     | none    |
| QG         | Gate Charge            | С     | none    |
| QB         | Body Charge            | С     | none    |
| QD         | Drain Charge           | С     | none    |
| QS         | Source Charge          | С     | none    |
| QJD        | Drain Junction Charge  | С     | none    |
| QJS        | Source Junction Charge | С     | none    |
| I_TOTAL_K  |                        | K     | none    |
| I_TOTAL_C  |                        | K     | none    |
| T_DELTA_SH |                        | K     | none    |

Table 2-109. BSIM-SOI 4.5.0 Device Instance Parameters

| Parameter | Description         | Units | Default |
|-----------|---------------------|-------|---------|
| AD        |                     | -     | 0       |
| AEBCP     |                     | _     | 0       |
| AGBCP     |                     | _     | 0       |
| AGBCP2    |                     | _     | 0       |
| AGBCPD    |                     | _     | 0       |
| AS        |                     | _     | 0       |
| BJTOFF    |                     | _     | 0       |
| CTH0      |                     | _     | 1e-05   |
| DELVTO    |                     | _     | 0       |
| DTEMP     |                     | _     | 0       |
| FRBODY    |                     | -     | 1       |
| L         |                     | -     | 5e-06   |
| М         | multiplicity factor | _     | 1       |
| NBC       |                     | -     | 0       |
| NF        |                     | _     | 1       |
| NRB       |                     | _     | 1       |
| NRD       |                     | _     | 1       |
| NRS       |                     | _     | 1       |
| NSEG      |                     | _     | 1       |
| OFF       |                     | _     | 0       |
| PD        |                     | _     | 0       |
| PDBCP     |                     | _     | 0       |
| PS        |                     | _     | 0       |
| PSBCP     |                     | _     | 0       |
| RBDB      |                     | _     | 50      |
| RBSB      |                     | _     | 50      |
| RTH0      |                     | _     | 0       |
| SA        |                     | _     | 0       |
| SB        |                     | _     | 0       |
| SD        |                     |       | 0       |
| SHMOD     |                     |       | 0       |
| SOIMOD    |                     |       | 0       |
| TNODEOUT  |                     |       | 0       |
| W         |                     | _     | 5e-06   |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default    |
|-----------|-------------|-------|------------|
| A0        |             | _     | 1          |
| A1        |             | _     | 0          |
| A2        |             | _     | 1          |
| ABJTII    |             | _     | 0          |
| ACDE      |             | _     | 1          |
| AD        |             | _     | 0          |
| ADOS      |             | _     | 1          |
| AEBCP     |             | _     | 0          |
| AELY      |             | _     | 0          |
| AF        |             | -     | 1          |
| AGB1      |             | _     | 3.7622e-07 |
| AGB2      |             | _     | 4.9758e-07 |
| AGBC2N    |             | _     | 3.4254e-07 |
| AGBC2P    |             | _     | 4.9723e-07 |
| AGBCP     |             | _     | 0          |
| AGBCP2    |             | _     | 0          |
| AGBCPD    |             | _     | 0          |
| AGIDL     |             | _     | 0          |
| AGISL     |             | _     | 0          |
| AGS       |             | _     | 0          |
| AHLI      |             | _     | 0          |
| AHLID     |             | _     | 0          |
| AIGBCP2   |             | _     | 0.043      |
| AIGC      |             | _     | 0          |
| AIGSD     |             | _     | 0          |
| ALPHA0    |             | _     | 0          |
| ALPHAGB1  |             | _     | 0.35       |
| ALPHAGB2  |             | _     | 0.43       |
| AS        |             | _     | 0          |
| ASD       |             | _     | 0.3        |
| AT        |             | -     | 33000      |
| в0        |             | _     | 0          |
| B1        |             | _     | 0          |
| BDOS      |             | _     | 1          |
| BETA0     |             | _     | 0          |
| BETA1     |             | _     | 0          |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default     |
|-----------|-------------|-------|-------------|
| BETA2     |             | -     | 0.1         |
| BETAGB1   |             | _     | 0.03        |
| BETAGB2   |             | _     | 0.05        |
| BF        |             | _     | 2           |
| BG0SUB    |             | _     | 1.16        |
| BGB1      |             | _     | -3.1051e+10 |
| BGB2      |             | _     | -2.357e+10  |
| BGBC2N    |             | -     | 1.1665e+12  |
| BGBC2P    |             | -     | 7.4567e+11  |
| BGIDL     |             | _     | 2.3e+09     |
| BGISL     |             | _     | 0           |
| BIGBCP2   |             | _     | 0.0054      |
| BIGC      |             | _     | 0           |
| BIGSD     |             | -     | 0           |
| BINUNIT   |             | _     | 1           |
| BJTOFF    |             | _     | 0           |
| CAPMOD    |             | _     | 2           |
| CBJTII    |             | _     | 0           |
| CDSBS     |             | _     | 0           |
| CDSC      |             | _     | 0.00024     |
| CDSCB     |             | _     | 0           |
| CDSCD     |             | _     | 0           |
| CF        |             | _     | 0           |
| CFRCOEFF  |             | _     | 1           |
| CGDL      |             | _     | 0           |
| CGDO      |             | _     | 0           |
| CGEO      |             | _     | 0           |
| CGIDL     |             | _     | 0.5         |
| CGISL     |             | _     | 0           |
| CGSL      |             | _     | 0           |
| CGSO      |             | _     | 0           |
| CIGBCP2   |             | _     | 0.0075      |
| CIGC      |             | -     | 0           |
| CIGSD     |             | _     | 0           |
| CIT       |             | _     | 0           |
| CJSWG     |             | _     | 1e-10       |
|           |             |       |             |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| CKAPPA       -       0.6         CLC       -       1e-08         CLE       -       0         CSDESW       -       0         CSDMIN       -       0         CTH0       -       1e-05         DEBUG       -       0  | Parameter | Description | Units | Default |
|--|-----------|-------------|-------|---------|
| CLC         -         1e-08           CLE         -         0           CSDESW         -         0           CSDMIN         -         0           CTH0         -         1e-05           DEBUG         -         0           DELTA         -         0.01           DELTAVOX         -         0.005           DELYT         -         0           DELYTO         -         0           DELYTO         -         0           DELGE         -         0           DLCB         -         0           DELCB         -         0           DELCB         -         0           DEVEB         -         0           DEVBOUT         -         0           DVBOUT         -         0           DVTDW         -         0           DVTPU         -         0           DVTPQ <td>CJSWGD</td> <td></td> <td></td> <td>0</td>         | CJSWGD    |             |       | 0       |
| CLE         -         0           CSDESW         -         0           CSDMIN         -         0           CTH0         -         1e-05           DEBUG         -         0           DELTA         -         0.01           DELTAD         -         0.005           DELIVTO         -         0           DELVTO         -         0           DLEG         -         0           DLCG         -         0           DLCG         -         0           DLCG         -         0           DLCIG         -         0           DLCIG         -         0           DKOUT         -         0           DKOUT         -         0           DVEDG         -         0           DVTOXCV         -         0           DVTOX         -         0           DVTO         -         2.2           DVTOW         -         0.53           DVT1W         -         0.53           DVT2W         -         0.032           DVTPQ         -         0   | CKAPPA    |             | _     | 0.6     |
| CSDRSW         -         0           CSDMIN         -         0           CTH0         -         1e-05           DEBUG         -         0           DELTA         -         0.01           DELTANOX         -         0.005           DELVT         -         0           DELVTO         -         0           DELVED         -         0           DLESB         -         0           DLCG         -         0           DLCB         -         0           DLCB         -         0           DLCG         -         0           DLCG         -         0           DLCG         -         0           DLCG         -         0           DKCG         -         0           DKDG         -         0           DVDG         -         0           DVBDO         -         0           DVDVD         -         0           DVTO         -         0           DVTO         -         0           DVTO         -         0           DVTD         <   | CLC       |             | _     | 1e-08   |
| CSDMIN         -         0           CTH0         -         1e-05           DEBUG         -         0           DELTA         -         0.01           DELTAWOX         -         0.005           DELVT         -         0           DELVTO         -         0           DELVED         -         0           DLEG         -         0           DLCG         -         0           DLCG         -         0           DLCIG         -         0           DLCIG         -         0           DROUT         -         0           DEVED         -         0           DVEDO         -         0           DVEDO         -         0           DVYDO         -         0           DVT1W         -         0.53           DVT1W         -         0.032           DVT2W         -         0.032           DVTP1         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0 <td< td=""><td>CLE</td><td></td><td>_</td><td>0</td></td<>   | CLE       |             | _     | 0       |
| CTHO         -         1e-05           DEBUG         -         0           DELTA         -         0.01           DELTAVOX         -         0.005           DELVT         -         0           DELVTO         -         0           DELVE         -         0           DLEBG         -         0           DLCG         -         0           DLCB         -         0           DLCIG         -         0           DROUT         -         0           DEVBUT         -         0           DVEDO         -         0           DVTO         -         0           DVTO         -         0           DVTO         -         0           DVT1         -         0           DVT2         -         0           DVT2W         -         0           DVT2W         -         0           DVTP0         -         0           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP3  | CSDESW    |             | _     | 0       |
| DEBUG   - 0.01     DELTA   | CSDMIN    |             | _     | 0       |
| DELTA         -         0.005           DELTAVOX         -         0.005           DELVT         -         0           DELVTO         -         0           DEX2B         -         0           DLGG         -         0           DLC         -         0           DLCB         -         0           DVDBD         -         0           DVTO         -         0           DVTD         -   | CTH0      |             | -     | 1e-05   |
| DELTAVOX         -         0.005           DELVTO         -         0           DELVTO         -         0           DEX2B         -         0           DLLG         -         0           DLCB         -         0           DLCB         -         0           DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DVEDO         -         0           DVEDO         -         0           DVYDO         -         0           DVYTO         -         0.53           DVYTO         -         0.53           DVYTI         -         0.032           DVYTQ         -         0.032           DVYTPQ         -         0  | DEBUG     |             | _     | 0       |
| DELVT         -         0           DELVTO         -         0           DEXB         -         0           DLEG         -         0           DLCB         -         0           DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DVBDQ         -         0           DVBDQ         -         0           DVTQ         -         0           DVTQ         -         0           DVT1         -         0.53           DVT1W         -         5.3e+06           DVT2         -         -0.032           DVT2W         -         -           DVTPQ         -         0           DVTP1         -         0           DVTP2         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DVTP4         -         0           DWB         -         0           DWB         -         0           DWBC   | DELTA     |             | _     | 0.01    |
| DELVTO         -         0           DEXB         -         0           DLEG         -         0           DLCB         -         0           DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DVBDQ         -         0           DVTQ         -         0           DVTQ         -         0           DVT1         -         0.53           DVT1W         -         5.3e+06           DVT2         -         -0.032           DVT2W         -         -         0           DVTPQ         -         0           DVTP1         -         0           DVTP2         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DVTP4         -         0           DVTP4         -         0           DVTP4         -         0           DWB         -         0           DWBC         -         0   | DELTAVOX  |             | _     | 0.005   |
| DEZB         -         0           DLC         -         0           DLCB         -         0           DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVT0         -         0           DVT0         -         0.53           DVT1         -         0.53           DVT2         -         0.032           DVT2W         -         0.032           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4   | DELVT     |             | _     | 0       |
| DLEG         -         0           DLCB         -         0           DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVBD1         -         0           DVT0         -         0.53           DVT1W         -         0.53           DVT2         -         -         0.032           DVT2W         -         -         0.032           DVTP0         -         0         0           DVT2W         -         0         0           DVTP0         -         0         0           DVTP1         -         0         0           DVTP2         -         0         0           DVTP3         -         0         0           DVTP4         -         0         0           DWB         -         0         0           DWBC         -         0         0  | DELVTO    |             |       | 0       |
| DLC         -         0           DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVT0         -         0           DVT0         -         0           DVT1         -         0.53           DVT1W         -         5.3e+06           DVT2         -         -           DVT2W         -         -           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP2         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DVTP5         -         0           DVTP6         -         0           DVTP9  | DK2B      |             | _     | 0       |
| DLCB         -         0           DLCIG         -         0.56           DROUT         -         0.56           DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVT0         -         0.53           DVT1         -         0.53           DVT1W         -         5.3e+06           DVT2         -         -0.032           DVT2W         -         -         0           DVTP0         -         0         0           DVTP1         -         0         0           DVTP2         -         0         0           DVTP3         -         0           DVTP4         -         0           DVTP5         -         0           DVTP6         -         0           DVTP7 <td>DLBG</td> <td></td> <td>_</td> <td>0</td> | DLBG      |             | _     | 0       |
| DLCIG         -         0           DROUT         -         0.56           DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVT0         -         0           DVT0         -         0           DVT1         -         0.53           DVT1W         -         0.53           DVT2         -         -         0.032           DVT2W         -         -         0           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DWB         -         0           DWBC         -         0  | DLC       |             | _     | 0       |
| DROUT         -         0.56           DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVBD1         -         0           DVT0         -         2.2           DVT0W         -         0           DVT1         -         0.53           DVT1W         -         0.032           DVT2W         -         -         0.032           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DWB         -         0           DWBC         -         0   | DLCB      |             | _     | 0       |
| DSUB         -         0           DTOXCV         -         0           DVBD0         -         0           DVBD1         -         0           DVT0         -         2.2           DVT0W         -         0           DVT1         -         0.53           DVT1W         -         5.3e+06           DVT2         -         -0.032           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DWB         -         0           DWBC         -         0  | DLCIG     |             | -     | 0       |
| DTOXCV         -         0           DVBD0         -         0           DVBD1         -         0           DVT0         -         2.2           DVT0W         -         0           DVT1         -         0.53           DVT1W         -         5.3e+06           DVT2         -         -0.032           DVTP0         -         0           DVTP1         -         0           DVTP2         -         0           DVTP2         -         0           DVTP3         -         0           DVTP4         -         0           DWB         -         0           DWBC         -         0   | DROUT     |             | _     | 0.56    |
| DVBD0 DVBD1 - 0 DVT0 - 2.2 DVT0W - 0 DVT1 - 0.53 DVT1W - 5.3e+06 DVT20.032 DVT2W0.032 DVTP0 - 0 DVTP1 - 0 DVTP1 - 0 DVTP1 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWBC - 0   | DSUB      |             | _     | 0       |
| DVBD1 - 0 DVT0 - 2.2 DVT0W - 0 DVT1 - 0.53 DVT1W - 5.3e+06 DVT20.032 DVT2W0.032 DVT2W - 0 DVTP0 - 0 DVTP1 - 0 DVTP1 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0  | DTOXCV    |             | _     | 0       |
| DVTO   | DVBD0     |             | -     | 0       |
| DVT0W - 0.53 DVT1W - 0.53 DVT2W 0.032 DVT2W 0.032 DVTP0 - 0 DVTP1 - 0 DVTP1 - 0 DVTP1 - 0 DVTP2 - 0 DVTP2 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0 DWBC - 0   | DVBD1     |             | _     | 0       |
| DVT1   | DVT0      |             | _     | 2.2     |
| DVT1W - 5.3e+06 DVT20.032 DVT2W0.032 DVTP0 - 0 DVTP1 - 0 DVTP2 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0   | DVT0W     |             | -     | 0       |
| DVT2W0.032 DVTP0 - 0 DVTP1 - 0 DVTP2 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0 DWBC - 0  | DVT1      |             | _     | 0.53    |
| DVT2W0.032 DVTP0 - 0 DVTP1 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0 DWBC - 0  | DVT1W     |             | _     | 5.3e+06 |
| DVTP0 - 0 DVTP1 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0 DWBC - 0   | DVT2      |             | _     | -0.032  |
| DVTP1 - 0 DVTP2 - 0 DVTP3 - 0 DVTP4 - 0 DWB - 0 DWBC - 0   | DVT2W     |             | _     | -0.032  |
| DVTP2       -       0         DVTP3       -       0         DVTP4       -       0         DWB       -       0         DWBC       -       0   | DVTP0     |             | _     | 0       |
| DVTP3 - 0 DVTP4 - 0 DWB - 0 DWBC - 0   | DVTP1     |             | _     | 0       |
| DVTP 4       -       0         DWB       -       0         DWBC       -       0  | DVTP2     |             | _     | 0       |
| DWB     -     0       DWBC     -     0   | DVTP3     |             | _     | 0       |
| DWBC - 0   | DVTP4     |             | -     | 0       |
|  | DWB       |             | _     | 0       |
| DWC - 0  | DWBC      |             | _     | 0       |
|  | DWC       |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| DWG       |             | -     | 0       |
| EASUB     |             | _     | 4.05    |
| EBG       |             | _     | 1.2     |
| EBJTII    |             | _     | 0       |
| EF        |             | _     | 1       |
| EGGBCP2   |             | _     | 1.12    |
| EGGDEP    |             | _     | 1.12    |
| EGIDL     |             | -     | 0       |
| EGISL     |             | _     | 0       |
| EM        |             | _     | 4.1e+07 |
| EOT       |             | _     | 1e-08   |
| EPSRGATE  |             | -     | 11.7    |
| EPSROX    |             | _     | 3.9     |
| EPSRSUB   |             | _     | 11.7    |
| ESATII    |             | -     | 1e+07   |
| ETA0      |             | _     | 0.08    |
| ETA0CV    |             | _     | 0       |
| ETAB      |             | _     | -0.07   |
| ETABCV    |             | _     | 0       |
| ETSI      |             | _     | 1e-07   |
| EU        |             | _     | 0       |
| FBJTII    |             | _     | 0       |
| FBODY     |             | _     | 1       |
| FDMOD     |             | _     | 0       |
| FGIDL     |             | _     | 0       |
| FGISL     |             | _     | 0       |
| FNOIMOD   |             | _     | 1       |
| FPROUT    |             | _     | 0       |
| FRBODY    |             | -     | 1       |
| GAMMA1    |             | _     | 0       |
| GAMMA2    |             | -     | 0       |
| GBMIN     |             | _     | 1e-12   |
| GIDLMOD   |             | _     | 0       |
| IDBJT     |             | _     | 0       |
| IDDIF     |             | _     | 0       |
| IDREC     |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| IDTUN     |             | _     | 0       |
| IGBMOD    |             | _     | 0       |
| IGCMOD    |             | _     | 0       |
| IGMOD     |             | _     | 0       |
| IIIMOD    |             | _     | 0       |
| ISBJT     |             | _     | 1e-06   |
| ISDIF     |             | _     | 0       |
| ISREC     |             | _     | 1e-05   |
| ISTUN     |             | _     | 0       |
| K1        |             | _     | 0.53    |
| K1B       |             | _     | 1       |
| K1W1      |             | -     | 0       |
| K1W2      |             | _     | 0       |
| K2        |             | _     | -0.0186 |
| K2B       |             | -     | 0       |
| K3        |             | _     | 0       |
| K3B       |             | _     | 0       |
| KB1       |             | _     | 1       |
| KETA      |             | _     | -0.6    |
| KETAS     |             | _     | 0       |
| KF        |             | _     | 0       |
| KGIDL     |             | _     | 0       |
| KGISL     |             | _     | 0       |
| KT1       |             | _     | -0.11   |
| KT1L      |             | _     | 0       |
| KT2       |             | _     | 0.022   |
| KU0       |             | _     | 0       |
| KVSAT     |             | -     | 0       |
| KVTH0     |             | -     | 0       |
| L         |             | -     | 5e-06   |
| LA0       |             | _     | 0       |
| LA1       |             | _     | 0       |
| LA2       |             | _     | 0       |
| LABJTII   |             | _     | 0       |
| LACDE     |             | -     | 0       |
| LAELY     |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| LAGIDL    |             | -     | 0       |
| LAGISL    |             | _     | 0       |
| LAGS      |             | _     | 0       |
| LAHLI     |             | _     | 0       |
| LAHLID    |             | _     | 0       |
| LAIGBCP2  |             | _     | 0       |
| LAIGC     |             | _     | 0       |
| LAIGSD    |             | _     | 0       |
| LALPHA0   |             | _     | 0       |
| LALPHAGB1 |             | _     | 0       |
| LALPHAGB2 |             | -     | 0       |
| LAT       |             | _     | 0       |
| LB0       |             | -     | 0       |
| LB1       |             | _     | 0       |
| LBETA0    |             | _     | 0       |
| LBETA1    |             | -     | 0       |
| LBETA2    |             | _     | 0       |
| LBETAGB1  |             | -     | 0       |
| LBETAGB2  |             | _     | 0       |
| LBGIDL    |             | _     | 0       |
| LBGISL    |             | -     | 0       |
| LBIGBCP2  |             | _     | 0       |
| LBIGC     |             | _     | 0       |
| LBIGSD    |             | _     | 0       |
| LBJT0     |             | _     | 2e-07   |
| LCBJTII   |             | _     | 0       |
| LCDSC     |             | _     | 0       |
| LCDSCB    |             | -     | 0       |
| LCDSCD    |             | -     | 0       |
| LCGDL     |             | -     | 0       |
| LCGIDL    |             | -     | 0       |
| LCGISL    |             | -     | 0       |
| LCGSL     |             | -     | 0       |
| LCIGBCP2  |             | _     | 0       |
| LCIGC     |             | _     | 0       |
| LCIGSD    |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| LCIT      |             | _     | 0       |
| LCKAPPA   |             | _     | 0       |
| LDELTA    |             | _     | 0       |
| LDELVT    |             | _     | 0       |
| LDIF0     |             | _     | 1       |
| LDROUT    |             | _     | 0       |
| LDSUB     |             | _     | 0       |
| LDVT0     |             | -     | 0       |
| LDVT0W    |             | _     | 0       |
| LDVT1     |             | _     | 0       |
| LDVT1W    |             | _     | 0       |
| LDVT2     |             | _     | 0       |
| LDVT2W    |             | -     | 0       |
| LDVTP0    |             | _     | 0       |
| LDVTP1    |             | _     | 0       |
| LDVTP2    |             | _     | 0       |
| LDVTP3    |             | -     | 0       |
| LDVTP4    |             | _     | 0       |
| LDWB      |             | _     | 0       |
| LDWG      |             | _     | 0       |
| LEBJTII   |             | _     | 0       |
| LEFFEOT   |             | _     | 1       |
| LEGIDL    |             | _     | 0       |
| LEGISL    |             | _     | 0       |
| LESATII   |             | _     | 0       |
| LETA0     |             | _     | 0       |
| LETA0CV   |             | _     | 0       |
| LETAB     |             | _     | 0       |
| LETABCV   |             | _     | 0       |
| LEU       |             | _     | 0       |
| LFBJTII   |             | _     | 0       |
| LFGIDL    |             | _     | 0       |
| LFGISL    |             | _     | 0       |
| LFPROUT   |             | -     | 0       |
| LIDBJT    |             | -     | 0       |
| LIDDIF    |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| LIDREC         -         0           LIT         -         0           LIT         -         0           LISBJT         -         0           LISBJT         -         0           LISBUF         -         0           LISTUN         -         0           LKIW         -         0           LKIW         -         0           LKIW         -         0           LKY         -         0           LKS         -         0           LKS         -         0           LKSB         -         0           LKSTA         -         0           LKY1         -         0           LKY1         -         0     | Parameter | Description | Units | Default |
|---|-----------|-------------|-------|---------|
| LITI       -       0         LISBJT       -       0         LISBJT       -       0         LISBUFF       -       0         LISTON       -       0         LKI       -       0         LKIM       -       0         LKIM2       -       0         LK2       -       0         LK3       -       0         LK3       -       0         LKB1       -       0         LKB1A       -<  | LIDREC    |             | _     | 0       |
| LINT         -         0           LISBJT         -         0           LISPEC         -         0           LISTUN         -         0           LKTUN         -         0           LKLW1         -         0           LKLW2         -         0           LK2         -         0           LK3         -         0           LK3         -         0           LKBA         -         0           LKBA         -         0           LKBA         -         0           LKBTA         -         0           LKETAS         -         0           LKETAS         -         0           LKGISL         -         0           LKTIL         -         0           LKTIL         -         0           LKTIL         -         0           LKVTHO         -         0           LL         -         0           LL         -         0           LLI         -         0           LLI         -         0           LLI         -          | LIDTUN    |             | _     | 0       |
| LISBUT         -         0           LISBUEC         -         0           LISTUN         -         0           LKI         -         0           LKIWI         -         0           LKIWI         -         0           LKIWI         -         0           LKI         -         0           LKI         -         0           LKS         -         0           LKSB         -         0           LKETAS         -         0           LKETAS         -         0           LKGIDL         -         0           LKTIL         -         0           LKTIL         -         0           LKTIL         -         0           LKYTO         -         0           LKVTHO         -         0           LL         -         0           LKYTHO         -         0           LLD         -         0           LLBJTO         -         0           LLI         -         0           LLI         -         0           LLODUTH         - | LII       |             | _     | 0       |
| LISBIF         -         0           LISTUN         -         0           LKI         -         0           LKIW1         -         0           LK1W2         -         0           LK2         -         0           LK3         -         0           LK3B         -         0           LKB1         -         0           LKETA         -         0           LKETAS         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT2         -         0           LKT1         -         0           LKT2         -         0           LKT2         -         0           LKY1H0         -         0           LLD         -         0<     | LINT      |             | _     | 0       |
| LISREC  | LISBJT    |             | _     | 0       |
| LKT         -         0           LKT         -         0           LKTWI         -         0           LKTW2         -         0           LK2         -         0           LK3         -         0           LK3B         -         0           LKB1         -         0           LKETA         -         0           LKETAS         -         0           LKGISL         -         0           LKT1         -         0           LKT1         -         0           LKT2         -         0           LKU0         -         0           LKVTHO         -         0           LL         -         0           LLSJTO         -         0           LLI         -         0              | LISDIF    |             | _     | 0       |
| LK1         -         0           LK1W1         -         0           LK2         -         0           LK3         -         0           LK3B         -         0           LKB1         -         0           LKETA         -         0           LKETAS         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT2         -         0           LKU0         -         0           LKVTHO         -         0           LLSJTO         -         0           LLDSJTO         -         0           LLLI         -         0           LLLI         -         0           LLOKUO         -         0           LLOKUO         -         0           LLOKUO         -         0           LLPEB         -         0           LMBJTII         -         0           LMBJTII         -         0  | LISREC    |             | _     | 0       |
| LK1W1         -         0           LK2         -         0           LK3         -         0           LK3B         -         0           LKB1         -         0           LKETA         -         0           LKETAS         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT1         -         0           LKY2         -         0           LKV0         -         0           LKV1H0         -         0           LLD         -         0           LLBJT0         -         0           LLD         -         0           LLIT         -         0           LLIT         -         0           LLIT         -         0           LLID         -         0           LLID         -         0           LLID         -         0           LLIPEO         -         0           LLIPED         -         0           LMBJTII         -      | LISTUN    |             | -     | 0       |
| LK1W2         -         0           LK2         -         0           LK3         -         0           LK3B         -         0           LKB1         -         0           LKETA         -         0           LKETAS         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT1         -         0           LKT2         -         0           LKU0         -         0           LKVTHO         -         0           LLDATTO         -         0           LLBJTO         -         0           LLI         -         0           LLI         -         0           LLI         -         0           LLI         -         0           LLODKUO         -         0           LLPEO         -         0           LLPED         -         0           LMBJTII         -         0           LMINU         -         0                            | LK1       |             | -     | 0       |
| LK2       -       0         LK3B       -       0         LKB1       -       0         LKETA       -       0         LKETAS       -       0         LKGIDL       -       0         LKTSSL       -       0         LKT1       -       0         LKT1       -       0         LKU0       -       0         LKVTHO       -       0         LLG       -       0         LLBJTO       -       0         LLI       -       0         LLODKUO       -       0         LLPEO       -       0         LLPED       -       0         LMBJTII       -       0         LMINU       -       0   | LK1W1     |             | _     | 0       |
| LK33       -       0         LKB1       -       0         LKETA       -       0         LKETAS       -       0         LKGIDL       -       0         LKGISL       -       0         LKT1       -       0         LKT1L       -       0         LKY2       -       0         LKV0       -       0         LLV       -       0         LLQ       -       0         LLD       -       0         LLI       -       0         LLI       -       0         LLQ       -       0         LLI       -       0         LLI       -       0         LLI       -       0         LLQ       -       0         LLI       -       0         LLI       -       0         LLI       -       0         LLI       -       0         LLQ       -       0         LLI       -       0         LLI       -       0         LLI       -       0   | LK1W2     |             | -     | 0       |
| LK3B       -       0         LKB1       -       0         LKETA       -       0         LKETAS       -       0         LKGIDL       -       0         LKGISL       -       0         LKT1       -       0         LKT1L       -       0         LKT2       -       0         LKU0       -       0         LLV       -       0         LLD       -       0         LLD       -       0         LLI       -       0         LLI       -       0         LLI       -       0         LLO       -       0         LLI       -       0         LLI       -       0         LLO       -       0   | LK2       |             | _     | 0       |
| LKB1         -         0           LKETAS         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT1L         -         0           LKT2         -         0           LKVDO         -         0           LKVTHO         -         0           LLDATO         -         0           LLC         -         0           LLIT         -         0           LLIT         -         0           LLOKUO         -         0           LLODKUO         -         0           LLODVTH         -         0           LLPEO         -         0           LMBJTII         -         0           LMINUY         -         0   | LK3       |             | _     | 0       |
| LKETA         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT1L         -         0           LKT2         -         0           LKV0         -         0           LKVTHO         -         0           LLG         -         0           LLG         -         0           LLIG         -         0           LLII         -         0           LLII         -         0           LLODKUO         -         0           LLODKUO         -         0           LLODKUO         -         0           LLODVTH         -         0           LLPEO         -         0           LMBJTII         -         0           LMINV         -         0  | LK3B      |             | _     | 0       |
| LKETAS         -         0           LKGIDL         -         0           LKGISL         -         0           LKT1         -         0           LKT1L         -         0           LKT2         -         0           LKV0         -         0           LKVTHO         -         0           LLBJTO         -         0           LLG         -         0           LLIT         -         0           LLIT         -         0           LLODKUO         -         0           LLODKUO         -         0           LLODKUO         -         0           LLODVTH         -         0           LLPEO         -         0           LLPEB         -         0           LMBJTII         -         0           LMINV         -         0   | LKB1      |             | -     | 0       |
| LKGIDL       -       0         LKGISL       -       0         LKT1       -       0         LKT2       -       0         LKU0       -       0         LKVTH0       -       0         LLBJT0       -       0         LLDJT0       -       0         LLII       -       0         LLII       -       0         LLOW       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0  | LKETA     |             | -     | 0       |
| LKGISL       -       0         LKT1       -       0         LKT1L       -       0         LKU2       -       0         LKU0       -       0         LKVTH0       -       0         LLBJT0       -       0         LLC       -       0         LLIT       -       0         LLN       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0  | LKETAS    |             | _     | 0       |
| LKT1       -       0         LKT2       -       0         LKU0       -       0         LKVTH0       -       0         LL       -       0         LLBJT0       -       0         LLC       -       0         LLII       -       0         LLII       -       0         LLN       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LKGIDL    |             | _     | 0       |
| LKT1L       -       0         LKT2       -       0         LKU0       -       0         LKVTH0       -       0         LL       -       0         LLBJT0       -       0         LLC       -       0         LLII       -       0         LLN       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LMBJTII       -       0         LMINV       -       0   | LKGISL    |             | _     | 0       |
| LKT2       -       0         LKU0       -       0         LKVTH0       -       0         LL       -       0         LLBJT0       -       0         LLC       -       0         LLII       -       0         LLN       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LMBJTII       -       0         LMINV       -       0   | LKT1      |             | _     | 0       |
| LKU0       -       0         LKVTH0       -       0         LL       -       0         LLBJT0       -       0         LLC       -       0         LLII       -       0         LLN       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LMBJTII       -       0         LMINV       -       0  | LKT1L     |             | _     | 0       |
| LKVTHO       -       0         LL       -       0         LLBJTO       -       0         LLC       -       0         LLII       -       0         LLN       -       1         LLODKUO       -       0         LLODVTH       -       0         LLPEO       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LKT2      |             | _     | 0       |
| LLBJT0       -       0         LLC       -       0         LLII       -       0         LLN       -       1         LLODKU0       -       0         LLODVTH       -       0         LLPE0       -       0         LMBJTII       -       0         LMINV       -       0   | LKU0      |             | -     | 0       |
| LLBJTO       -       0         LLC       -       0         LLII       -       0         LLN       -       1         LLODKUO       -       0         LLODVTH       -       0         LLPEO       -       0         LMBJTII       -       0         LMINV       -       0   | LKVTH0    |             | -     | 0       |
| LLC       -       0         LLTI       -       0         LLN       -       1         LLODKUO       -       0         LLODVTH       -       0         LLPEO       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0  | LL        |             | _     | 0       |
| LLII       -       0         LLODKUO       -       0         LLODVTH       -       0         LLPEO       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0  | LLBJT0    |             | _     | 0       |
| LLN       -       1         LLODKUO       -       0         LLODVTH       -       0         LLPEO       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LLC       |             | _     | 0       |
| LLODKUO       -       0         LLODVTH       -       0         LLPEO       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LLII      |             | _     | 0       |
| LLODVTH       -       0         LLPE0       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LLN       |             | _     | 1       |
| LLPE0       -       0         LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LLODKU0   |             | _     | 0       |
| LLPEB       -       0         LMBJTII       -       0         LMINV       -       0   | LLODVTH   |             | -     | 0       |
| LMBJTII       -       0         LMINV       -       0   | LLPE0     |             | -     | 0       |
| LMINV - 0   | LLPEB     |             | -     | 0       |
|   | LMBJTII   |             | -     | 0       |
| LMINVCV - 0   | LMINV     |             | _     | 0       |
|   | LMINVCV   |             | -     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

|  | Parameter | Description | Units | Default |
|--|-----------|-------------|-------|---------|
| NBJT   | LMOIN     |             |       | 0       |
| ENCH         -         0           LNDIF         -         0           LNDIODE         -         0           LNDIODED         -         0           LNDIACTOR         -         0           LNGATE         -         0           LNGIDL         -         0           LNIGC         -         0           LNIGC         -         0           LNDIFF         -         0           LNDIFF         -         0           LNESCFO         -         0           LNESCFOD         -         0           LNESCRO         -         0           LNESCRO         -         0           LNESCRO         -         0           LNESUB         -         0           LNTSUB         -         0           LNTRECF         -         0           LNTRECF         -         0           LNTRECF         -         0           LNTUND         -         0           LODETAO         -         1           LODETAO         -         0           LODETAO         -         0 <t< td=""><td>LN</td><td></td><td>_</td><td>2e-06</td></t<>  | LN        |             | _     | 2e-06   |
| ENDIF         -         0           LNDIODE         -         0           LNFACTOR         -         0           LNFACTOR         -         0           LNEATE         -         0           LNEGIDL         -         0           LNIGC         -         0           LNIGC         -         0           LNEW         -         0           LNRECFO         -         0           LNRECFO         -         0           LNEECRO         -         0           LNSUB         -         0           LNTRECF         -         0           LNTRECF         -         0           LNTRECF         -         0           LNTRUTH         -         0           LNTRECF         -         0  | LNBJT     |             | _     | 0       |
| LNDIODE         -         0           LNFACTOR         -         0           LNGATE         -         0           LNGATE         -         0           LNGATE         -         0           LNGGE         -         0           LNIGC         -         0           LNIGC         -         0           LNOFF         -         0           LNRECFO         -         0           LNRECRO         -         0           LNEECRO         -         0           LNSUB         -         0           LNTRECF         -         0           LNTRECF         -         0           LNTRUTH         -         0           LNTUND         -         0           LODETAOCV         -         0           LODETAOCV         -         0           LODETAOCV         -         0           LPDIBLC1         -         0           LPDIBLC2         -         0           LPDIBLC3         -         0           LPDIBLCB         -         0           LPDIBLCB         -         0 </td <td>LNCH</td> <td></td> <td>_</td> <td>0</td> | LNCH      |             | _     | 0       |
| LNDIODED         -         0           LNFACTOR         -         0           LNGATE         -         0           LNIGC         -         0           LNIGC         -         0           LNIGC         -         0           LNIGC         -         0           LNOFF         -         0           LNECFO         -         0           LNRECFOD         -         0           LNRECRO         -         0           LNSD         -         0           LNSUB         -         0           LNTRECF         -         0           LNTRECF         -         0           LNTURUN         -         0           LNTUND         -         0           LODETAO         -         1           LODETAO         -         0           LPDIELOCY         -         0           LPDIBLC1         -         0           LPDIBLC2         -         0           LPDITSD         -         0           LPDITSD         -         0           LPDITSD         -         0      <  | LNDIF     |             | _     | 0       |
| LINFACTOR         -         0           LINGATE         -         0           LINGIDL         -         0           LINIGC         -         0           LINIX         -         0           LINIX         -         0           LINIX         -         0           LINIX         -         0           LINECFO         -         0           LINECFOD         -         0           LINISD         -         0           LINISUB         -         0           LINITRECF         -         0           LINITRECF         -         0           LINITUND         -         0           LINITUND         -         0           LODETAGO         -         1           LODETAGO         -         1           LODETAGO         -         0           LUPLING         -         0  | LNDIODE   |             | -     | 0       |
| LNGGTE         -         0           LNIGC         -         0           LNLX         -         0           LNGFF         -         0           LNRECF0         -         0           LNRECF0D         -         0           LNRECR0D         -         0           LNSUB         -         0           LNTRECF         -         0           LNTRECR         -         0           LNTRECR         -         0           LNTUND         -         0           LNTUND         -         0           LODETAO         -         1           LODETAO         -         1           LODETAO         -         0           LEPELM         -         0           LEPELM         -         0           LEPELM         -         0           LEPELBLECL         -         0   | LNDIODED  |             | -     | 0       |
| LNIGC         -         0           LNIX         -         0           LNOFF         -         0           LNRECF0         -         0           LNRECF0D         -         0           LNRECR0D         -         0           LNSD         -         0           LNSUB         -         0           LNTRECF         -         0           LNTUN         -         0           LNTUN         -         0           LODETAO         -         1           LODETAOCV         -         0           LODK2         -         1           LPCLM         -         0           LPDIBLC1         -         0           LPDIBLC2         -         0           LPDIBLCB         -         0           LPDITSD         -         0           LPDITSD         -         0           LPED         -         0           LPED         -         0           LPDITSD         -         0           LPED         -         0           LPDITSD         -         0  | LNFACTOR  |             | -     | 0       |
| LNIGC         -         0           LNOFF         -         0           LNRECF0         -         0           LNRECF0D         -         0           LNRECR0         -         0           LNSD         -         0           LNSUB         -         0           LNTRECF         -         0           LNTUN         -         0           LNTUN         -         0           LNTUND         -         0           LODETA0C         -         1           LODETA0CV         -         0           LODK2         -         1           LPDIBLCD         -         0           LPDIBLC2         -         0           LPDIBLC2         -         0           LPDITS         -         0           LPDITSD         -         0           LPEG         -         0           LPEB         -         0           LPEG         -         0           LPEGCD         -         0  | LNGATE    |             | -     | 0       |
| LNIX         -         0           LNOFF         -         0           LNRECF0         -         0           LNRECR0         -         0           LNRECR0D         -         0           LNSD         -         0           LNSUB         -         0           LNTRECF         -         0           LNTUN         -         0           LNTUN         -         0           LNTUND         -         0           LODETAOCV         -         0           LODEX2         -         1           LPCLM         -         0           LPDIBLC1         -         0           LPDIBLC2         -         0           LPDIBLCB         -         0           LPDITSD         -         0           LPDITSD         -         0           LPED         -         0           LPED         -         0           LPDITSD         -         0           LPDITSD         -         0           LPDITSD         -         0           LPDITSD         -         0  | LNGIDL    |             | -     | 0       |
| LNOFF         -         0           LNRECFO         -         0           LNRECRO         -         0           LNRECROD         -         0           LNSD         -         0           LNSUB         -         0           LNTRECF         -         0           LNTURECR         -         0           LNTUN         -         0           LNTUND         -         0           LODETAO         -         1           LODETAOCV         -         0           LODK2         -         1           LPCLM         -         0           LPDIBLC1         -         0           LPDIBLC2         -         0           LPDIBLCB         -         0           LPDITS         -         0           LPDITSD         -         0           LPED         -         0           LPED         -         0           LPED         -         0           LPDITSD         -         0           LPDITSD         -         0           LPDITSD         -         0   | LNIGC     |             | -     | 0       |
| LNRECFO         -         0           LNRECRO         -         0           LNRECROD         -         0           LNSD         -         0           LNSUB         -         0           LNTRECF         -         0           LNTUN         -         0           LNTUND         -         0           LODETAO         -         1           LODETAOCV         -         0           LODK2         -         1           LPCLM         -         0           LPDIBLCQ         -         0           LPDIBLCS         -         0           LPDITS         -         0           LPDITSD         -         0           LPEG         -         0           LPEB         -         0           LPEB         -         0           LPEGCD         -         0  | LNLX      |             |       | 0       |
| LINRECFOD   - 0   C   C   C   C   C   C   C   C   C  | LNOFF     |             |       | 0       |
| LINECROD   | LNRECF0   |             | -     | 0       |
| LNRECROD         -         0           LNSDB         -         0           LNTRECF         -         0           LNTURECR         -         0           LNTUN         -         0           LNTUND         -         0           LODETAOCV         -         1           LODK2         -         1           LPCLM         -         0           LPDIBLC1         -         0           LPDIBLC2         -         0           LPDIBLCB         -         0           LPDITS         -         0           LPDITSD         -         0           LPED         -         0           LPEB         -         0           LPIGCD         -         0  | LNRECF0D  |             | -     | 0       |
| NSD  | LNRECR0   |             | -     | 0       |
| NEW  | LNRECR0D  |             | _     | 0       |
| LINTRECF   | LNSD      |             | -     | 0       |
| LINTRECR       -       0         LINTUN       -       0         LODETAO       -       1         LODETAOCV       -       0         LODK2       -       1         LPCLM       -       0         LPDIBLC1       -       0         LPDIBLC2       -       0         LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPEO       -       0         LPEB       -       0         LPIGCD       -       0   | LNSUB     |             | _     | 0       |
| LNTUN  LNTUND  LODETAO  LODETAOCV  LODEX  LODEX  - 0  LPCLM  LPCLM  - 0  LPDIBLC1  - 0  LPDIBLC2  - 0  LPDIBLC2  - 0  LPDIBLCB  - 0  LPDITSD  LPDITSD  LPEO  LPEO  LPEO  LPEO  LPEO  LPEO  LPEO  LPIGCD  - 0  LPIGCD  - 0  LPIGCD  | LNTRECF   |             | -     | 0       |
| LNTUND - 0 LODETAO - 1 LODETAOCV - 0 LODK2 - 1 LPCLM - 0 LPDIBLC1 - 0 LPDIBLC2 - 0 LPDIBLC2 - 0 LPDIBLCB - 0 LPDITS - 0 LPDITS - 0 LPDITSD - 0   | LNTRECR   |             | _     | 0       |
| LODETAOCV - 0 LODK2 - 1 LPCLM - 0 LPDIBLC1 - 0 LPDIBLC2 - 0 LPDIBLCB - 0 LPDITS - 0 LPDITS - 0 LPDITSD - 0   | LNTUN     |             | -     | 0       |
| LODETAOCV       -       0         LODK2       -       1         LPCLM       -       0         LPDIBLC1       -       0         LPDIBLC2       -       0         LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0   | LNTUND    |             | -     | 0       |
| LODK2       -       1         LPCLM       -       0         LPDIBLC1       -       0         LPDIBLC2       -       0         LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0   | LODETA0   |             | _     | 1       |
| LPCLM       -       0         LPDIBLC1       -       0         LPDIBLC2       -       0         LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPEO       -       0         LPEB       -       0         LPIGCD       -       0   | LODETAOCV |             | _     | 0       |
| LPDIBLC1       -       0         LPDIBLC2       -       0         LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0   | LODK2     |             | -     | 1       |
| LPDIBLC2       -       0         LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0  | LPCLM     |             | _     | 0       |
| LPDIBLCB       -       0         LPDITS       -       0         LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0   | LPDIBLC1  |             | -     | 0       |
| LPDITS       -       0         LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0  | LPDIBLC2  |             | -     | 0       |
| LPDITSD       -       0         LPE0       -       0         LPEB       -       0         LPIGCD       -       0   | LPDIBLCB  |             | -     | 0       |
| LPE0       -       0         LPEB       -       0         LPIGCD       -       0   | LPDITS    |             | -     | 0       |
| LPEB       -       0         LPIGCD       -       0  | LPDITSD   |             | _     | 0       |
| LPIGCD - 0   | LPE0      |             | _     | 0       |
|  | LPEB      |             | _     | 0       |
| LPOXEDGE – 0   | LPIGCD    |             | -     | 0       |
|  | LPOXEDGE  |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| LPRNT         -         0           LPRNG         -         0           LPVAG         -         0           LRDW         -         0           LRDW         -         0           LRDW         -         0           LRGIDL         -         0           LRSW         -         0           LSTIQ         -         0           LSTIQ         -         0           LSTIQ         -         0           LSTIQ         -         0           LWA         -         0           LWA         -         0           LWA         -         0           LWB         -         0  | Parameter | Description | Units | Default |
|---|-----------|-------------|-------|---------|
| DERWIST   | LPRT      |             | -     | 0       |
| LPVAG         -         0           LRDSW         -         0           LRDW         -         0           LRGIDL         -         0           LRGISI         -         0           LRSW         -         0           LSII0         -         0           LSII1         -         0           LSIID         -         0           LU0         -         0           LU0         -         0           LUA         -         0           LUC         -         0           LUC         -         0           LUCS         -         0           LUD1         -         0           LUD1         -         0           LUD1         -         0           LUD1         -         0  | LPRWB     |             | _     | 0       |
| LRDW         -         0           LRGIDL         -         0           LRGISL         -         0           LRSW         -         0           LSI10         -         0           LSI11         -         0           LSI12         -         0           LSI1D         -         0           LU0         -         0           LUA         -         0           LUA         -         0           LUA         -         0           LUB         -         0           LUB         -         0           LUC1         -         0           LUC3         -         0           LUC3         -         0           LUC3         -         0           LUC3         -         0           LUC4         -         0           LUC5         -         0           LUC5         -         0           LUD1         -         0           LUD2         -         0           LVBC1         -         0           LVBC2         -         0 </td <td>LPRWG</td> <td></td> <td>-</td> <td>0</td> | LPRWG     |             | -     | 0       |
| LRDW         -         0           LRGIDL         -         0           LRGISL         -         0           LRSW         -         0           LSIIO         -         0           LSII1         -         0           LSIID         -         0           LUG         -         0           LUA         -         0           LUA         -         0           LUB         -         0           LUB         -         0           LUC         -         0           LUC         -         0           LUC         -         0           LUCS         -         0           LUCS         -         0           LUCS         -         0           LUD         -         0           LUD         -         0           LUS         -         0           LVBAJT         -         0           LVFB         -         0           LVRECO         -         0           LVRECOD         -         0           LVSAT         -         0 </td <td>LPVAG</td> <td></td> <td>-</td> <td>0</td> | LPVAG     |             | -     | 0       |
| LRGIDL         -         0           LRGISL         -         0           LRSW         -         0           LSII0         -         0           LSII1         -         0           LSII2         -         0           LUA         -         0           LUA         -         0           LUA         -         0           LUB         -         0           LUB         -         0           LUC         -         0           LUC         -         0           LUCS         -         0           LUD1         -         0           LVBAJT         -         0           LVPSATIO         -         0           LVOFFCV         -         0           LVPSCCO         -         0           LVSAT         -         0           LVSDFB         -  | LRDSW     |             | _     | 0       |
| LRGISL       -       0         LRSW       -       0         LSI10       -       0         LSI11       -       0         LSI12       -       0         LSI1D       -       0         LU0       -       0         LU0       -       0         LUA1       -       0         LUB       -       0         LUC       -       0         LUC       -       0         LUCS       -       0         LUCSTE       -       0         LUD       -       0         LUD       -       0         LUDI       -       0         LUDI       -       0         LUDI       -       0         LVDA       -       0         LVDA       -       0         LVDSATII0       -       0         LVOFF       -       0         LVPECO       -       0         LVRECO       -       0         LVSDFB       -       0  | LRDW      |             | _     | 0       |
| LSIN         -         0           LU0         -         0           LUA         -         0           LUA         -         0           LUB         -         0           LUC         -         0           LUC         -         0           LUCS         -         0           LUCSTE         -         0           LUD         -         0           LVD         -         0           LVDA         -         0           LVBAJT         -         0           LVOFF         -         0           LVPECO         -         0           LVSAT         -         0           LVSDFB         -         0  | LRGIDL    |             | _     | 0       |
| LSI10         -         0           LSI12         -         0           LSID         -         0           LU0         -         0           LUA         -         0           LUA         -         0           LUB         -         0           LUB         -         0           LUC         -         0           LUC1         -         0           LUCS         -         0           LUCSTE         -         0           LUD1         -         0           LUD1         -         0           LUD1         -         0           LUD1         -         0           LUD2         -         0           LUABJT         -         0           LVPSATI10         -         0           LVOFF         -         0           LVPSECO         -         0           LVRECOD         -         0           LVSDFB         -         0  | LRGISL    |             | _     | 0       |
| LSIT12       -       0         LSITD       -       0         LU0       -       0         LUA       -       0         LUA1       -       0         LUB       -       0         LUB       -       0         LUC       -       0         LUCS       -       0         LUCSTE       -       0         LUD       -       0         LUD       -       0         LUTE       -       0         LUTE       -       0         LVABJT       -       0         LVPSATI10       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVSAT       -       0         LVSDFB       -       0  | LRSW      |             | _     | 0       |
| LSI12       -       0         LU0       -       0         LUA       -       0         LUA1       -       0         LUB       -       0         LUB       -       0         LUC       -       0         LUC1       -       0         LUCS       -       0         LUCS       -       0         LUD       -       0         LUD       -       0         LUDI       -       0         LUTE       -       0         LVABJT       -       0         LVFB       -       0         LVFB       -       0         LVFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSDFB       -       0   | LSIIO     |             | -     | 0       |
| LSIID       -       0         LUA       -       0         LUAI       -       0         LUB       -       0         LUBI       -       0         LUC       -       0         LUCS       -       0         LUCSTE       -       0         LUDI       -       0         LUDI       -       0         LUTE       -       0         LVABJT       -       0         LVFB       -       0         LVFB       -       0         LVOFF       -       0         LVRECO       -       0         LVRECOD       -       0         LVSDFB       -       0   | LSII1     |             | _     | 0       |
| LUO       -       0         LUA1       -       0         LUB       -       0         LUB1       -       0         LUC       -       0         LUC1       -       0         LUCS       -       0         LUCSTE       -       0         LUD       -       0         LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVFB       -       0         LVFB       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSDFB       -       0   | LSII2     |             | _     | 0       |
| LUA         -         0           LUB         -         0           LUB         -         0           LUC         -         0           LUC1         -         0           LUCS         -         0           LUCSTE         -         0           LUD         -         0           LUD1         -         0           LUTE         -         0           LVABJT         -         0           LVBGI         -         0           LVFB         -         0           LVFB         -         0           LVOFFCV         -         0           LVRECO         -         0           LVRECOD         -         0           LVSDFB         -         0   | LSIID     |             | _     | 0       |
| LUB1       -       0         LUB1       -       0         LUC       -       0         LUC1       -       0         LUCS       -       0         LUCSTE       -       0         LUD       -       0         LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVSAT       -       0         LVSDFB       -       0  | LU0       |             | _     | 0       |
| LUB1       -       0         LUC       -       0         LUC1       -       0         LUCS       -       0         LUCSTE       -       0         LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVDSATII0       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LUA       |             | _     | 0       |
| LUB1       -       0         LUC       -       0         LUC1       -       0         LUCS       -       0         LUD       -       0         LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LUA1      |             | _     | 0       |
| LUC         -         0           LUCS         -         0           LUCSTE         -         0           LUD         -         0           LUD1         -         0           LUTE         -         0           LVABJT         -         0           LVBCI         -         0           LVDSATII0         -         0           LVFB         -         0           LVOFFCV         -         0           LVRECO         -         0           LVRECOD         -         0           LVSAT         -         0           LVSDFB         -         0   | LUB       |             | _     | 0       |
| LUC1       -       0         LUCS       -       0         LUCSTE       -       0         LUD       -       0         LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVSAT       -       0         LVSDFB       -       0  | LUB1      |             | _     | 0       |
| LUCS         -         0           LUCSTE         -         0           LUD         -         0           LUD1         -         0           LUTE         -         0           LVABJT         -         0           LVBCI         -         0           LVDSATI10         -         0           LVOFF         -         0           LVOFFCV         -         0           LVRECO         -         0           LVSAT         -         0           LVSDFB         -         0  | LUC       |             | _     | 0       |
| LUCSTE       -       0         LUD       -       0         LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVDSATIO       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVSAT       -       0         LVSDFB       -       0   | LUC1      |             | _     | 0       |
| LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVDSATIIO       -       0         LVFB       -       0         LVOFF       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0   | LUCS      |             | _     | 0       |
| LUD1       -       0         LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVDSATII0       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0   | LUCSTE    |             | _     | 0       |
| LUTE       -       0         LVABJT       -       0         LVBCI       -       0         LVDSATII0       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LUD       |             | _     | 0       |
| LVABJT       -       0         LVBCI       -       0         LVDSATII0       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0   | LUD1      |             | _     | 0       |
| LVBCI       -       0         LVDSATIIO       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LUTE      |             | _     | 0       |
| LVDSATIIO       -       0         LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LVABJT    |             | _     | 0       |
| LVFB       -       0         LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LVBCI     |             | _     | 0       |
| LVOFF       -       0         LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0   | LVDSATII0 |             | _     | 0       |
| LVOFFCV       -       0         LVRECO       -       0         LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0   | LVFB      |             | -     | 0       |
| LVREC0       -       0         LVREC0D       -       0         LVSAT       -       0         LVSDFB       -       0   | LVOFF     |             | _     | 0       |
| LVRECOD       -       0         LVSAT       -       0         LVSDFB       -       0  | LVOFFCV   |             |       | 0       |
| LVSAT - 0 LVSDFB - 0  | LVREC0    |             |       | 0       |
| LVSDFB - 0  | LVREC0D   |             |       | 0       |
|   | LVSAT     |             | _     | 0       |
| LVSDTH - 0  | LVSDFB    |             | _     | 0       |
|   | LVSDTH    |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| LVTH0     |             | -     | 0       |
| LVTUN0    |             | _     | 0       |
| LVTUN0D   |             | _     | 0       |
| LW        |             | _     | 0       |
| LWO       |             | _     | 0       |
| LWC       |             | _     | 0       |
| LWL       |             | _     | 0       |
| LWLC      |             | _     | 0       |
| LWN       |             | _     | 1       |
| LWR       |             | _     | 0       |
| LXBJT     |             | _     | 0       |
| LXDIF     |             | _     | 0       |
| LXDIFD    |             | _     | 0       |
| LXJ       |             | _     | 0       |
| LXRCRG1   |             | _     | 0       |
| LXRCRG2   |             | _     | 0       |
| LXREC     |             | _     | 0       |
| LXRECD    |             | _     | 0       |
| LXTUN     |             | _     | 0       |
| LXTUND    |             | _     | 0       |
| MBJTII    |             | _     | 0.4     |
| MINV      |             | _     | 0       |
| MINVCV    |             | _     | 0       |
| MJSWG     |             | _     | 0.5     |
| MJSWGD    |             | _     | 0       |
| MOBMOD    |             | _     | 1       |
| MOIN      |             | _     | 15      |
| MOINFD    |             | _     | 1000    |
| MTRLMOD   |             | _     | 0       |
| NBC       |             | _     | 0       |
| NBJT      |             | -     | 1       |
| NCH       |             | _     | 1.7e+17 |
| NDIF      |             | -     | -1      |
| NDIODE    |             | _     | 1       |
| NDIODED   |             | _     | 0       |
| NF        |             | _     | 1       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default  |
|-----------|-------------|-------|----------|
| NFACTOR   |             | _     | 1        |
| NGATE     |             | _     | 0        |
| NGCON     |             | _     | 1        |
| NGIDL     |             | _     | 1.2      |
| NIOSUB    |             | _     | 1.45e+10 |
| NIGC      |             | _     | 1        |
| NLX       |             | _     | 1.74e-07 |
| NOFF      |             | _     | 1        |
| NOFFFD    |             | _     | 1        |
| NOIA      |             | _     | 0        |
| NOIB      |             | _     | 0        |
| NOIC      |             | _     | 8.75e+09 |
| NOIF      |             | _     | 1        |
| NRB       |             | _     | 1        |
| NRD       |             | _     | 1        |
| NRECF0    |             | _     | 2        |
| NRECF0D   |             | _     | 0        |
| NRECR0    |             | _     | 10       |
| NRECROD   |             | _     | 0        |
| NRS       |             | _     | 1        |
| NSD       |             | _     | 1e+20    |
| NSEG      |             | _     | 1        |
| NSUB      |             | _     | 6e+16    |
| NTNOI     |             | _     | 1        |
| NTOX      |             | _     | 1        |
| NTRECF    |             | _     | 0        |
| NTRECR    |             | _     | 0        |
| NTUN      |             | _     | 10       |
| NTUND     |             | _     | 0        |
| OFF       |             | _     | 0        |
| PA0       |             | -     | 0        |
| PA1       |             | _     | 0        |
| PA2       |             | -     | 0        |
| PABJTII   |             | _     | 0        |
| PACDE     |             | -     | 0        |
| PAELY     |             | _     | 0        |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| PAGIDL    |             | -     | 0       |
| PAGISL    |             | _     | 0       |
| PAGS      |             | _     | 0       |
| PAHLI     |             | -     | 0       |
| PAHLID    |             | _     | 0       |
| PAIGBCP2  |             | _     | 0       |
| PAIGC     |             | _     | 0       |
| PAIGSD    |             | _     | 0       |
| PALPHA0   |             | _     | 0       |
| PALPHAGB1 |             | _     | 0       |
| PALPHAGB2 |             | -     | 0       |
| PARAMCHK  |             | _     | 0       |
| PAT       |             | -     | 0       |
| PB0       |             | -     | 0       |
| PB1       |             | _     | 0       |
| PBETA0    |             | _     | 0       |
| PBETA1    |             | _     | 0       |
| PBETA2    |             | _     | 0       |
| PBETAGB1  |             | _     | 0       |
| PBETAGB2  |             | _     | 0       |
| PBGIDL    |             | _     | 0       |
| PBGISL    |             | _     | 0       |
| PBIGBCP2  |             | _     | 0       |
| PBIGC     |             | -     | 0       |
| PBIGSD    |             | _     | 0       |
| PBSWG     |             | -     | 0.7     |
| PBSWGD    |             | -     | 0       |
| PCBJTII   |             | _     | 0       |
| PCDSC     |             | _     | 0       |
| PCDSCB    |             | _     | 0       |
| PCDSCD    |             | _     | 0       |
| PCGDL     |             | -     | 0       |
| PCGIDL    |             | -     | 0       |
| PCGISL    |             | _     | 0       |
| PCGSL     |             | _     | 0       |
| PCIGBCP2  |             | _     | 0       |
|           |             |       |         |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| PCIGC     |             | -     | 0       |
| PCIGSD    |             | _     | 0       |
| PCIT      |             | _     | 0       |
| PCKAPPA   |             | _     | 0       |
| PCLM      |             | _     | 1.3     |
| PD        |             | _     | 0       |
| PDBCP     |             | _     | 0       |
| PDELTA    |             | _     | 0       |
| PDELVT    |             | _     | 0       |
| PDIBLC1   |             | _     | 0.39    |
| PDIBLC2   |             | _     | 0.0086  |
| PDIBLCB   |             | _     | 0       |
| PDITS     |             | -     | 1e-20   |
| PDITSD    |             | _     | 0       |
| PDITSL    |             | _     | 0       |
| PDROUT    |             | -     | 0       |
| PDSUB     |             | _     | 0       |
| PDVT0     |             | -     | 0       |
| PDVT0W    |             | _     | 0       |
| PDVT1     |             | _     | 0       |
| PDVT1W    |             | -     | 0       |
| PDVT2     |             | _     | 0       |
| PDVT2W    |             | _     | 0       |
| PDVTP0    |             | _     | 0       |
| PDVTP1    |             | _     | 0       |
| PDVTP2    |             | _     | 0       |
| PDVTP3    |             | _     | 0       |
| PDVTP4    |             | _     | 0       |
| PDWB      |             | _     | 0       |
| PDWG      |             | _     | 0       |
| PEBJTII   |             | -     | 0       |
| PEGIDL    |             | -     | 0       |
| PEGISL    |             | -     | 0       |
| PESATII   |             | _     | 0       |
| PETA0     |             | _     | 0       |
| PETA0CV   |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| PETABSCY         -         0           PBU         -         0           PPBUTTI         -         0           PPBUTTI         -         0           PPGIDL         -         0           PPGIDL         -         0           PETROT         -         0           PHIG         -         4.05           PIDBT         -         0           PIDDTP         -         0           PIDOTON         -         0           PISOCD         -         1           PISOTI         -         0           PKINI         -         0           PKINI         -         0           PKINI         -         0           PKSB         -         0           PKSB         -         0           PKSB         -         0           PKSB         -         0           PKSB <th>Parameter</th> <th>Description</th> <th>Units</th> <th>Default</th> | Parameter | Description | Units | Default |
|--|-----------|-------------|-------|---------|
| PEU         -         0           PFBJTI1         -         0           PFGIDL         -         0           PFGIDL         -         0           PFFROUT         -         0           PFPROUT         -         0           PFTROUT         -         0           PIDG         -         0           PIDBJT         -         0           PIDDIF         -         0           PIGCD         -         1           PISBJT         -         0           PISBLT         -         0           PISREC         -         0           PISTUN         -         0           PKI         -         0           PKIWI         -         0           PKIWI         -         0           PKIWI         -         0           PKS3         -         0           PKS3         -         0           PKB1         -         0           PKB1         -         0           PKB2         -         0           PKB3         -         0           PKB4  | PETAB     |             | -     | 0       |
| PFBJTITI         -         0           PFGIDL         -         0           PFGISL         -         0           PFBROUT         -         0           PFBROUT         -         0           PHIG         -         4.05           PIDBJT         -         0           PIDDIT         -         0           PIDREC         -         0           PIGCD         -         1           PISBDT         -         0           PISBREC         -         0           PISTUN         -         0           PKINEL         -         0           PKINEL         -         0           PKINEL         -         0           PKINEL         -         0           PKS         -         0           PKSB  | PETABCV   |             | _     | 0       |
| PFGIDL         -         0           PFGGISL         -         0           PFPROUT         -         0           PFDGOT         -         0           PHIG         -         4.05           PIDDIT         -         0           PIDDIT         -         0           PIDTON         -         0           PISSBJT         -         0           PISSBJT         -         0           PISTEC         -         0           PISTUN         -         0           PKI         -         0           PKIW1         -         0           PKIW2         -         0           PKX2         -         0           PKX3         -         0           PKXB         -         0           PKBI  | PEU       |             | _     | 0       |
| PFGISL         -         0           PFPROUT         -         0           PHIG         -         4.05           PIDBJT         -         0           PIDDIF         -         0           PIDTOR         -         0           PIDTUN         -         0           PISTOR         -         0           PISSBJT         -         0           PISSBLY         -         0           PK1         -         0           PK1         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PK5B         -         0           PK5BLY         -         0           PK5BLY         -         0           PK5BLY         -         0           PK5BLY         -         0           PK5BL  | PFBJTII   |             | _     | 0       |
| PFPROUT         -         4.05           PIDBJT         -         0           PIDDIF         -         0           PIDDIF         -         0           PIDDIUN         -         0           PIGCD         -         1           PISBJT         -         0           PISBJT         -         0           PISREC         -         0           PKI         -         0           PKS         -         0           PKB         -         0           PKB         -         0           PKBI         -         0           PKETAS         -         0           PKETAS         -         0           PKETAS         -         0           PKETA         -         0           PKETA         -   | PFGIDL    |             | _     | 0       |
| PHIG         -         4.05           PIDBJT         -         0           PIDDLF         -         0           PIDREC         -         0           PIDTUN         -         0           PIGCD         -         1           PISBJT         -         0           PISBJT         -         0           PISREC         -         0           PKIND         -         0           PKINT         -         0           PKINT         -         0           PKX         -         0           PKX         -         0           PKX3         -         0           PKB1         -         0           PKB2         -         0           PKB3         -         0           PKB4         -         0           PKB1         -         0           PKB2         -         0           PKG1DL         -         0           PKG1L         -         0           PKT1         -         0           PKT2         -         0           PKVH0         - </td <td>PFGISL</td> <td></td> <td>_</td> <td>0</td>                            | PFGISL    |             | _     | 0       |
| PIDDIT         -         0           PIDREC         -         0           PIDTUN         -         0           PIGDD         -         1           PISBJT         -         0           PISREC         -         0           PISTUN         -         0           PK14         -         0           PK1M2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PK81B         -         0           PKB1A  | PFPROUT   |             | _     | 0       |
| PIDDIF         -         0           PIDTUN         -         0           PIGCD         -         1           PISBJT         -         0           PISDIF         -         0           PISTEC         -         0           PK1         -         0           PKMI         -         0           PKWI         -         0           PK3         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETAS         -         0           PKETAS         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKU0         -         0           PKVTHO         -         0           PLBJTO         -         0   | PHIG      |             | _     | 4.05    |
| PIDREC         -         0           PIDTUN         -         0           PIGED         -         1           PISBJT         -         0           PISDIF         -         0           PISTUN         -         0           PK1         -         0           PK1W1         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKT2         -         0           PKU0         -         0           PKU0         -         0           PKVTHO         -         0           PLBJTO         -         0           PLBJTO         -         0  | PIDBJT    |             | _     | 0       |
| PIDTUN         -         0           PIGCD         -         1           PISBJT         -         0           PISDIF         -         0           PISTUN         -         0           PK1         -         0           PK1W1         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT1         -         0           PKT2         -         0           PKT2         -         0           PKU0         -         0           PKVTH0         -         0           PLBJT0         -         0           PLBJT0         -         0   | PIDDIF    |             | _     | 0       |
| PIGCD         -         1           PISBJT         -         0           PISBTEC         -         0           PISTUN         -         0           PK1         -         0           PK1W1         -         0           PK1W2         -         0           PK3         -         0           PK3B         -         0           PK81         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKT2         -         0           PKW2         -         0           PKW1         -         0           PKW1         -         0           PKW1         -         0           PKW2         -         0           PKW1         -         0           PKW1         -         0           PKW1         -         0           PKW2         -         0           PKW2         -  | PIDREC    |             | _     | 0       |
| PISBJT         -         0           PISBJEC         -         0           PISTUN         -         0           PK1         -         0           PK1W1         -         0           PK1W2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKT2         -         0           PKU0         -         0           PKVTH0         -         0           PLBJT0         -         0           PLBJT0         -         0  | PIDTUN    |             | _     | 0       |
| PISNEC         -         0           PISTUN         -         0           PK1         -         0           PK1W1         -         0           PK1W2         -         0           PK2         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKU0         -         0           PKVTHO         -         0           PLBJTO         -         0           PLBJTO         -         0   | PIGCD     |             | _     | 1       |
| PISREC         -         0           PK1         -         0           PK1W1         -         0           PK1W2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKE1A         -         0           PKETA         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKT2         -         0           PKU0         -         0           PKVTHO         -         0           PLBJTO         -         0           PLBJTO         -         0   | PISBJT    |             | _     | 0       |
| PISTUN         -         0           PK1         -         0           PK1W1         -         0           PK1W2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKU0         -         0           PKVTHO         -         0           PKVTHO         -         0           PLIT         -         0  | PISDIF    |             | _     | 0       |
| PK1         -         0           PK1W1         -         0           PK1W2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKETAS         -         0           PKGIDL         -         0           PKT1         -         0           PKT1         -         0           PKT1L         -         0           PKT2         -         0           PKU0         -         0           PKVTH0         -         0           PLBJT0         -         0           PLIII         -         0  | PISREC    |             | _     | 0       |
| PK1W1         -         0           PK1W2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT1L         -         0           PKT2         -         0           PKU0         -         0           PKVTH0         -         0           PLBJT0         -         0           PLII         -         0  | PISTUN    |             | _     | 0       |
| PK1W2         -         0           PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT1L         -         0           PKT2         -         0           PKU0         -         0           PKVTH0         -         0           PLBJT0         -         0           PLII         -         0   | PK1       |             | _     | 0       |
| PK2         -         0           PK3         -         0           PK3B         -         0           PKB1         -         0           PKETA         -         0           PKETAS         -         0           PKGIDL         -         0           PKGISL         -         0           PKT1         -         0           PKT2         -         0           PKU0         -         0           PKVTH0         -         0           PLBJT0         -         0           PLBJT0         -         0   | PK1W1     |             | _     | 0       |
| PK3       -       0         PKBB       -       0         PKB1       -       0         PKETA       -       0         PKETAS       -       0         PKGIDL       -       0         PKTS       -       0         PKT1       -       0         PKT2       -       0         PKVD0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0  | PK1W2     |             | _     | 0       |
| PK3B       -       0         PKB1       -       0         PKETA       -       0         PKETAS       -       0         PKGIDL       -       0         PKGISL       -       0         PKT1       -       0         PKT1L       -       0         PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PK2       |             | _     | 0       |
| PKB1       -       0         PKETA       -       0         PKETAS       -       0         PKGIDL       -       0         PKT1       -       0         PKT1L       -       0         PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PK3       |             | _     | 0       |
| PKETAS       -       0         PKGIDL       -       0         PKGISL       -       0         PKT1       -       0         PKT1L       -       0         PKU2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PK3B      |             | _     | 0       |
| PKETAS       -       0         PKGIDL       -       0         PKGISL       -       0         PKT1       -       0         PKT1L       -       0         PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PKB1      |             | _     | 0       |
| PKGIDL       -       0         PKGISL       -       0         PKT1       -       0         PKT2L       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PKETA     |             | _     | 0       |
| PKGISL       -       0         PKT1       -       0         PKT1L       -       0         PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PKETAS    |             | _     | 0       |
| PKT1       -       0         PKT1L       -       0         PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0  | PKGIDL    |             | _     | 0       |
| PKT1L       -       0         PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PKGISL    |             | _     | 0       |
| PKT2       -       0         PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PKT1      |             | _     | 0       |
| PKU0       -       0         PKVTH0       -       0         PLBJT0       -       0         PLII       -       0  | PKT1L     |             | _     | 0       |
| PKVTH0       -       0         PLBJT0       -       0         PLII       -       0   | PKT2      |             | -     | 0       |
| PLBJT0       -       0         PLII       -       0  | PKU0      |             | -     | 0       |
| PLII - 0   | PKVTH0    |             | -     | 0       |
|  | PLBJT0    |             | _     | 0       |
| PLPEO - O  | PLII      |             | _     | 0       |
|  | PLPE0     |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| PLPEB     |             | -     | 0       |
| PMBJTII   |             | _     | 0       |
| PMINV     |             | _     | 0       |
| PMINVCV   |             | _     | 0       |
| PMOIN     |             | _     | 0       |
| PNBJT     |             | -     | 0       |
| PNCH      |             | -     | 0       |
| PNDIF     |             | -     | 0       |
| PNDIODE   |             | -     | 0       |
| PNDIODED  |             | -     | 0       |
| PNFACTOR  |             | -     | 0       |
| PNGATE    |             | -     | 0       |
| PNGIDL    |             | -     | 0       |
| PNIGC     |             | -     | 0       |
| PNLX      |             | _     | 0       |
| PNOFF     |             | -     | 0       |
| PNRECF0   |             | _     | 0       |
| PNRECF0D  |             | _     | 0       |
| PNRECR0   |             | _     | 0       |
| PNRECR0D  |             | _     | 0       |
| PNSD      |             | -     | 0       |
| PNSUB     |             | -     | 0       |
| PNTRECF   |             | -     | 0       |
| PNTRECR   |             | -     | 0       |
| PNTUN     |             | -     | 0       |
| PNTUND    |             | -     | 0       |
| POXEDGE   |             | -     | 1       |
| PPCLM     |             | -     | 0       |
| PPDIBLC1  |             | -     | 0       |
| PPDIBLC2  |             | -     | 0       |
| PPDIBLCB  |             | -     | 0       |
| PPDITS    |             | -     | 0       |
| PPDITSD   |             | -     | 0       |
| PPIGCD    |             | -     | 0       |
| PPOXEDGE  |             | _     | 0       |
| PPRT      |             | _     | 0       |
|           |             |       |         |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| PPRWB     |             | -     | 0       |
| PPRWG     |             | _     | 0       |
| PPVAG     |             | _     | 0       |
| PRDSW     |             | _     | 0       |
| PRDW      |             | -     | 0       |
| PRGIDL    |             | -     | 0       |
| PRGISL    |             | -     | 0       |
| PRSW      |             | -     | 0       |
| PRT       |             | -     | 0       |
| PRWB      |             | -     | 0       |
| PRWG      |             | -     | 0       |
| PS        |             | -     | 0       |
| PSBCP     |             | _     | 0       |
| PSIIO     |             | _     | 0       |
| PSII1     |             | _     | 0       |
| PSII2     |             | _     | 0       |
| PSIID     |             | _     | 0       |
| PU0       |             | _     | 0       |
| PUA       |             | _     | 0       |
| PUA1      |             | _     | 0       |
| PUB       |             | _     | 0       |
| PUB1      |             | _     | 0       |
| PUC       |             | _     | 0       |
| PUC1      |             | _     | 0       |
| PUCS      |             | _     | 0       |
| PUCSTE    |             | -     | 0       |
| PUD       |             | _     | 0       |
| PUD1      |             | _     | 0       |
| PUTE      |             | _     | 0       |
| PVABJT    |             | _     | 0       |
| PVAG      |             | _     | 0       |
| PVBCI     |             | _     | 0       |
| PVDSATII0 |             | -     | 0       |
| PVFB      |             | _     | 0       |
| PVOFF     |             | _     | 0       |
| PVOFFCV   |             | _     | 0       |
|           |             |       |         |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| PVREC0    |             | -     | 0       |
| PVREC0D   |             | _     | 0       |
| PVSAT     |             | _     | 0       |
| PVSDFB    |             | _     | 0       |
| PVSDTH    |             | _     | 0       |
| PVTH0     |             | _     | 0       |
| PVTUN0    |             | _     | 0       |
| PVTUN0D   |             | _     | 0       |
| PW0       |             | _     | 0       |
| PWR       |             | -     | 0       |
| PXBJT     |             | _     | 0       |
| PXDIF     |             | _     | 0       |
| PXDIFD    |             | _     | 0       |
| PXJ       |             | _     | 0       |
| PXRCRG1   |             | _     | 0       |
| PXRCRG2   |             | _     | 0       |
| PXREC     |             | _     | 0       |
| PXRECD    |             | _     | 0       |
| PXTUN     |             | _     | 0       |
| PXTUND    |             | _     | 0       |
| RBDB      |             | _     | 50      |
| RBODY     |             | _     | 0       |
| RBODYMOD  |             | _     | 0       |
| RBSB      |             | _     | 50      |
| RBSH      |             | _     | 0       |
| RDSMOD    |             | _     | 0       |
| RDSW      |             | _     | 100     |
| RDW       |             | _     | 50      |
| RDWMIN    |             | -     | 0       |
| RGATEMOD  |             | -     | 0       |
| RGIDL     |             | _     | 1       |
| RGISL     |             | -     | 0       |
| RHALO     |             | -     | 1e+15   |
| RNOIA     |             | _     | 0.577   |
| RNOIB     |             | _     | 0.37    |
| RSH       |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default  |
|-----------|-------------|-------|----------|
| RSHG      |             | -     | 0.1      |
| RSW       |             | _     | 50       |
| RSWMIN    |             | _     | 0        |
| RTH0      |             | _     | 0        |
| SA        |             | _     | 0        |
| SAREF     |             | _     | 1e-06    |
| SB        |             | _     | 0        |
| SBREF     |             | _     | 1e-06    |
| SD        |             | _     | 0        |
| SHMOD     |             | _     | 0        |
| SIIO      |             | _     | 0.5      |
| SII1      |             | _     | 0.1      |
| SII2      |             | _     | 0        |
| SIID      |             | _     | 0        |
| SOIMOD    |             | _     | 0        |
| STETA0    |             | _     | 0        |
| STETA0CV  |             | -     | 0        |
| STK2      |             | _     | 0        |
| TBGASUB   |             | _     | 0.000702 |
| TBGBSUB   |             | _     | 1108     |
| TBOX      |             | _     | 3e-07    |
| ICJSWG    |             | _     | 0        |
| ICJSWGD   |             | _     | 0        |
| TEMPEOT   |             | _     | 300.15   |
| ΓΙΙ       |             | _     | 0        |
| TKU0      |             | _     | 0        |
| TNOIA     |             | _     | 1.5      |
| TNOIB     |             | -     | 3.5      |
| TNOIMOD   |             | -     | 0        |
| INOM      |             | -     | 27       |
| IOX       |             | -     | 1e-08    |
| TOXM      |             | _     | 0        |
| TOXP      |             | _     | 0        |
| TOXQM     |             | -     | 0        |
| TOXREF    |             | _     | 2.5e-09  |
| TPBSWG    |             | _     | 0        |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default   |
|-----------|-------------|-------|-----------|
| TPBSWGD   |             | _     | 0         |
| TSI       |             | _     | 1e-07     |
| TT        |             | _     | 1e-12     |
| TVBCI     |             | _     | 0         |
| TYPE      |             | _     | 1         |
| U0        |             | _     | 0         |
| UA        |             | _     | 2.25e-09  |
| UA1       |             | -     | 4.31e-09  |
| UB        |             | _     | 5.87e-19  |
| UB1       |             | -     | -7.61e-18 |
| UC        |             | _     | 0         |
| UC1       |             | _     | 0         |
| UCS       |             | _     | 0         |
| UCSTE     |             | _     | -0.004775 |
| UD        |             | _     | 0         |
| UD1       |             | -     | 0         |
| UTE       |             | _     | -1.5      |
| VABJT     |             | -     | 10        |
| VBCI      |             | _     | 0         |
| VBM       |             | _     | -3        |
| VBS0FD    |             | _     | 0.5       |
| VBS0PD    |             | _     | 0         |
| VBSA      |             | _     | 0         |
| VBSUSR    |             | _     | 0         |
| VBX       |             | _     | 0         |
| VDDEOT    |             | _     | 0         |
| VDSATII0  |             | _     | 0.9       |
| VECB      |             | -     | 0.026     |
| VERSION   |             | -     | 4.4       |
| VEVB      |             | _     | 0.075     |
| VFB       |             | -     | -1        |
| VGB1      |             | -     | 300       |
| VGB2      |             | -     | 17        |
| VGSTCVMOD |             | _     | 0         |
| VOFF      |             | _     | -0.08     |
| VOFFCV    |             | _     | 0         |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| VOFFFD    |             | _     | 0       |
| VOXH      |             | _     | 5       |
| VREC0     |             | _     | 0       |
| VREC0D    |             | _     | 0       |
| VSAT      |             | _     | 80000   |
| VSCE      |             | _     | 0       |
| VSDFB     |             | _     | 0       |
| VSDTH     |             | -     | 0       |
| VTH0      |             | -     | 0       |
| VTHO      |             | -     | 0       |
| VTM00     |             | -     | 0.026   |
| VTUN0     |             | -     | 0       |
| VTUN0D    |             | _     | 0       |
| W         |             | -     | 5e-06   |
| WO        |             | _     | 2.5e-06 |
| WOFLK     |             | _     | 1e-05   |
| WA0       |             | _     | 0       |
| WA1       |             | _     | 0       |
| WA2       |             | -     | 0       |
| WABJTII   |             | -     | 0       |
| WACDE     |             | _     | 0       |
| WAELY     |             | _     | 0       |
| WAGIDL    |             | _     | 0       |
| WAGISL    |             | _     | 0       |
| WAGS      |             | _     | 0       |
| WAHLI     |             | _     | 0       |
| WAHLID    |             | -     | 0       |
| WAIGBCP2  |             | -     | 0       |
| WAIGC     |             | -     | 0       |
| WAIGSD    |             | _     | 0       |
| WALPHA0   |             | -     | 0       |
| WALPHAGB1 |             | _     | 0       |
| WALPHAGB2 |             | _     | 0       |
| WAT       |             | _     | 0       |
| WB0       |             | _     | 0       |
| WB1       |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WBETA0    |             | _     | 0       |
| WBETA1    |             | _     | 0       |
| WBETA2    |             | _     | 0       |
| WBETAGB1  |             | _     | 0       |
| WBETAGB2  |             | _     | 0       |
| WBGIDL    |             | _     | 0       |
| WBGISL    |             | _     | 0       |
| WBIGBCP2  |             | _     | 0       |
| WBIGC     |             | _     | 0       |
| WBIGSD    |             | _     | 0       |
| WCBJTII   |             | -     | 0       |
| WCDSC     |             | _     | 0       |
| WCDSCB    |             | -     | 0       |
| WCDSCD    |             | _     | 0       |
| WCGDL     |             | _     | 0       |
| WCGIDL    |             | -     | 0       |
| WCGISL    |             | _     | 0       |
| WCGSL     |             | _     | 0       |
| WCIGBCP2  |             | _     | 0       |
| WCIGC     |             | _     | 0       |
| WCIGSD    |             | -     | 0       |
| WCIT      |             | _     | 0       |
| WCKAPPA   |             | _     | 0       |
| WDELTA    |             | _     | 0       |
| WDELVT    |             | _     | 0       |
| WDROUT    |             | _     | 0       |
| WDSUB     |             | _     | 0       |
| WDVT0     |             | _     | 0       |
| WDVT0W    |             | -     | 0       |
| WDVT1     |             | _     | 0       |
| WDVT1W    |             | _     | 0       |
| WDVT2     |             | _     | 0       |
| WDVT2W    |             | -     | 0       |
| WDVTP0    |             | _     | 0       |
| WDVTP1    |             | _     | 0       |
| WDVTP2    |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WDVTP3    |             | -     | 0       |
| WDVTP4    |             | _     | 0       |
| WDWB      |             | _     | 0       |
| WDWG      |             | -     | 0       |
| WEBJTII   |             | _     | 0       |
| WEFFEOT   |             | _     | 10      |
| WEGIDL    |             | _     | 0       |
| WEGISL    |             | _     | 0       |
| WESATII   |             | _     | 0       |
| WETA0     |             | _     | 0       |
| WETA0CV   |             | _     | 0       |
| WETAB     |             | _     | 0       |
| WETABCV   |             | _     | 0       |
| WEU       |             | _     | 0       |
| WFBJTII   |             | _     | 0       |
| WFGIDL    |             | _     | 0       |
| WFGISL    |             | _     | 0       |
| WFPROUT   |             | _     | 0       |
| WIDBJT    |             | _     | 0       |
| WIDDIF    |             | _     | 0       |
| WIDREC    |             | _     | 0       |
| WIDTUN    |             | _     | 0       |
| WINT      |             | _     | 0       |
| WISBJT    |             | _     | 0       |
| WISDIF    |             | _     | 0       |
| WISREC    |             | _     | 0       |
| WISTUN    |             | _     | 0       |
| WK1       |             | _     | 0       |
| WK1W1     |             | _     | 0       |
| WK1W2     |             | _     | 0       |
| WK2       |             | -     | 0       |
| WK3       |             | -     | 0       |
| WK3B      |             | -     | 0       |
| WKB1      |             | -     | 0       |
| WKETA     |             | _     | 0       |
| WKETAS    |             | _     | 0       |
|           |             |       |         |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WKGIDL    |             | _     | 0       |
| WKGISL    |             | _     | 0       |
| WKT1      |             | _     | 0       |
| WKT1L     |             | _     | 0       |
| WKT2      |             | _     | 0       |
| WKU0      |             | _     | 0       |
| WKVTH0    |             | _     | 0       |
| WL        |             | _     | 0       |
| WLBJT0    |             | _     | 0       |
| WLC       |             | -     | 0       |
| WLII      |             | _     | 0       |
| WLN       |             | -     | 1       |
| WLOD      |             | _     | 0       |
| WLODKU0   |             | -     | 0       |
| WLODVTH   |             | _     | 0       |
| WLPE0     |             | _     | 0       |
| WLPEB     |             | _     | 0       |
| WMBJTII   |             | _     | 0       |
| WMINV     |             | _     | 0       |
| WMINVCV   |             | _     | 0       |
| WMOIN     |             | _     | 0       |
| WNBJT     |             | _     | 0       |
| WNCH      |             | _     | 0       |
| WNDIF     |             | _     | 0       |
| WNDIODE   |             | _     | 0       |
| WNDIODED  |             | _     | 0       |
| WNFACTOR  |             | -     | 0       |
| WNGATE    |             | _     | 0       |
| WNGIDL    |             | _     | 0       |
| WNIGC     |             | -     | 0       |
| WNLX      |             | _     | 0       |
| WNOFF     |             | -     | 0       |
| WNRECF0   |             | -     | 0       |
| WNRECF0D  |             | _     | 0       |
| WNRECR0   |             | _     | 0       |
| WNRECROD  |             | _     | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WNSD      |             | -     | 0       |
| WNSUB     |             | _     | 0       |
| WNTRECF   |             | _     | 0       |
| WNTRECR   |             | -     | 0       |
| WNTUN     |             | _     | 0       |
| WNTUND    |             | _     | 0       |
| WPCLM     |             | _     | 0       |
| WPDIBLC1  |             | _     | 0       |
| WPDIBLC2  |             | _     | 0       |
| WPDIBLCB  |             | _     | 0       |
| WPDITS    |             | _     | 0       |
| WPDITSD   |             | _     | 0       |
| WPIGCD    |             | _     | 0       |
| WPOXEDGE  |             | _     | 0       |
| WPRT      |             | _     | 0       |
| WPRWB     |             | _     | 0       |
| WPRWG     |             | _     | 0       |
| WPVAG     |             | _     | 0       |
| WR        |             | _     | 1       |
| WRDSW     |             | _     | 0       |
| WRDW      |             | _     | 0       |
| WRGIDL    |             | _     | 0       |
| WRGISL    |             | _     | 0       |
| WRSW      |             | -     | 0       |
| WSIIO     |             | _     | 0       |
| WSII1     |             | -     | 0       |
| WSII2     |             | _     | 0       |
| WSIID     |             | -     | 0       |
| WTH0      |             | _     | 0       |
| WU0       |             | _     | 0       |
| WUA       |             | -     | 0       |
| WUA1      |             | _     | 0       |
| WUB       |             | _     | 0       |
| WUB1      |             | _     | 0       |
| WUC       |             | -     | 0       |
| WUC1      |             |       | 0       |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WUCS      |             | -     | 0       |
| WUCSTE    |             | _     | 0       |
| WUD       |             | _     | 0       |
| WUD1      |             | _     | 0       |
| WUTE      |             | _     | 0       |
| WVABJT    |             | -     | 0       |
| WVBCI     |             | -     | 0       |
| WVDSATII0 |             | -     | 0       |
| WVFB      |             | -     | 0       |
| WVOFF     |             | -     | 0       |
| WVOFFCV   |             | -     | 0       |
| WVREC0    |             | -     | 0       |
| WVREC0D   |             | _     | 0       |
| WVSAT     |             | _     | 0       |
| WVSDFB    |             | _     | 0       |
| WVSDTH    |             | _     | 0       |
| WVTH0     |             | _     | 0       |
| WVTUN0    |             | _     | 0       |
| WVTUNOD   |             | _     | 0       |
| WW        |             | _     | 0       |
| WWO       |             | _     | 0       |
| WWC       |             | _     | 0       |
| WWL       |             | _     | 0       |
| WWLC      |             | _     | 0       |
| WWN       |             | _     | 1       |
| WWR       |             | -     | 0       |
| WXBJT     |             | -     | 0       |
| WXDIF     |             | -     | 0       |
| WXDIFD    |             | -     | 0       |
| WXJ       |             | -     | 0       |
| WXRCRG1   |             | _     | 0       |
| WXRCRG2   |             | _     | 0       |
| WXREC     |             | -     | 0       |
| WXRECD    |             | _     | 0       |
| WXTUN     |             | _     | 0       |
| WXTUND    |             | _     | 0       |
|           |             |       |         |

Table 2-110. BSIM-SOI 4.5.0 Device Model Parameters

| Parameter | Description | Units | Default  |
|-----------|-------------|-------|----------|
| XBJT      |             | _     | 1        |
| XDIF      |             | _     | 0        |
| XDIFD     |             | _     | 0        |
| XGL       |             | _     | 0        |
| XGW       |             | _     | 0        |
| XJ        |             | _     | 0        |
| XPART     |             | _     | 0        |
| XRCRG1    |             | _     | 12       |
| XRCRG2    |             | _     | 1        |
| XREC      |             | -     | 1        |
| XRECD     |             | _     | 0        |
| XT        |             | _     | 1.55e-07 |
| XTUN      |             | _     | 0        |
| XTUND     |             | _     | 0        |

Table 2-111. MOSFET level 70450 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| VDSAT     | VDSAT       | _     | none    |
| VTH       | VTH         | _     | none    |
| IDS       | IDS         | -     | none    |
| GM        | GM          | _     | none    |
| GDS       | GDS         | -     | none    |
| GMBS      | GMBS        | _     | none    |
| IC        | IC          | -     | none    |
| IBD       | IBD         | -     | none    |
| IBS       | IBS         | -     | none    |
| IGIDL     | IGIDL       | _     | none    |
| IGISL     | IGISL       | _     | none    |
| IGS       | IGS         | -     | none    |
| IGD       | IGD         | _     | none    |
| IGB       | IGB         | _     | none    |
| IGCS      | IGCS        | _     | none    |
| IGCD      | IGCD        | _     | none    |
| CGG       | CGG         | _     | none    |
| CGS       | CGS         | _     | none    |

Table 2-111. MOSFET level 70450 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| CGD       | CGD         | _     | none    |
| CBG       | CBG         | _     | none    |
| CBD       | CBD         | _     | none    |
| CBS       | CBS         | _     | none    |
| CDG       | CDG         | _     | none    |
| CDD       | CDD         | -     | none    |
| CDS       | CDS         | _     | none    |
| CAPBD     | CAPBD       | _     | none    |
| CAPBS     | CAPBS       | _     | none    |
| QG        | QG          | _     | none    |
| QB        | QB          | _     | none    |
| QD        | QD          | _     | none    |
| QS        | QS          | -     | none    |
| QJD       | QJD         | -     | none    |
| QJS       | QJS         | -     | none    |

## 2.3.20.10. Level 77 MOSFET Tables (BSIM6 version 6.1.1)

Xyce includes the BSIM6 MOSFET model, version 6.1.1. Full documentation of the BSIM6 is available at its web site, http://bsim.berkeley.edu/models/bsim6/. Instance and model parameters for the BSIM6 are given in tables 2-112 and 2-113. These tables are generated directly from information present in the original Verilog-A implementation of the BSIM6, and lack many descriptions for the parameters. Consult the BSIM6 technical manual from the BSIM group for further details about these parameters.

Beginning with version 7.2 of Xyce, an optional fifth node may be specified for BSIM6 devices. If specified, it is the temperature node, which is used by the self-heating model and is internal if not specified on the instance line.

The BSIM6 device supports output of the internal variables in table 2-114 on the .PRINT line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific level 77 M device in your netlist.

Table 2-112, BSIM6 Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| AD        | Drain to Substrate Junction Area                                      | _     | 0       |
| AS        | Source to Substrate Junction Area                                     | _     | 0       |
| GEOMOD    | Geo dependent parasitics model  | _     | 0       |
| L         |   | m     | 1e-05   |
| М         | multiplicity factor   | _     | 1       |
| MINZ      | Minimize either D or S  | _     | 0       |
| NF        | Number of fingers   | _     | 1       |
| NGCON     | Number of gate contacts   | _     | 1       |
| NRD       | Number of squares in drain  | _     | 1       |
| NRS       | Number of squares in source   | _     | 1       |
| PD        | Drain to Substrate Junction Perimeter                                 | _     | 0       |
| PS        | Source to Substrate Junction Perimeter                                | _     | 0       |
| RBDB      | Resistance between bNode and dbNode                                   | _     | 50      |
| RBODYMOD  | Distributed body R model  | _     | 0       |
| RBPB      | Resistance between bNodePrime and bNode                               | _     | 50      |
| RBPD      | Resistance between bNodePrime and bNode                               | _     | 50      |
| RBPS      | Resistance between bNodePrime and sbNode                              | _     | 50      |
| RBSB      | Resistance between bNode and sbNode                                   | _     | 50      |
| RGATEMOD  | Gate resistance model selector  | _     | 0       |
| RGEOMOD   | Geometry-dependent source/drain resistance, 0: RSH-based, 1: Holistic | _     | 0       |
| SA        | Distance between OD edge from Poly from one side                      | _     | 0       |
| SB        | Distance between OD edge from Poly from other side                    | _     | 0       |

**Table 2-112. BSIM6 Device Instance Parameters** 

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| SC        | Distance to a single well edge if <=0.0, turn off WPE | _     | 0       |
| SCA       |   | _     | 0       |
| SCB       |   | _     | 0       |
| SCC       |   | _     | 0       |
| SD        | Distance between neighboring fingers                  | _     | 0       |
| VFBSDOFF  |   | _     | 0       |
| W         | Total width including fingers                         | m     | 1e-05   |
| XGW       | Dist from gate contact center to dev edge [m]         | m     | 0       |

Table 2-113. BSIM6 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| A1        | Non-saturation effect parameter for strong inversion region   | _     | 0       |
| A11       | Temperature dependence of A1                                  | _     | 0       |
| A2        | Non-saturation effect parameter for moderate inversion region | _     | 0       |
| A21       | Temperature dependence of A2                                  | _     | 0       |
| ADOS      | Quantum mechanical effect prefactor cum switch in inversion   | _     | 0       |
| AGIDL     | pre-exponential coeff. for GIDL in mho                        | _     | 0       |
| AGIDLL    | Length dependence coefficient of AGIDL                        | _     | 0       |
| AGIDLW    | Width dependence coefficient of AGIDL                         | _     | 0       |
| AGISL     | pre-exponential coeff. for GISL                               | _     | 0       |
| AGISLL    | Length dependence coefficient of AGISL                        | _     | 0       |
| AGISLW    | Width dependence coefficient of AGISL                         | _     | 0       |
| AIGBACC   | Parameter for Igb   | _     | 0.0136  |
| AIGBINV   | Parameter for Igb   | _     | 0.0111  |
| AIGC      | Parameter for Igc   | _     | 0       |
| AIGCL     | Length dependence coefficient of AIGC                         | _     | 0       |
| AIGCW     | Width dependence coefficient of AIGC                          | _     | 0       |
| AIGD      | Parameter for Igs d   | _     | 0       |
| AIGDL     | Length dependence coefficient of AIGD                         | _     | 0       |
| AIGDW     | Width dependence coefficient of AIGD                          |       | 0       |
| AIGS      | Parameter for Igs d   |       | 0       |
| AIGSL     | Length dependence coefficient of AIGS                         | _     | 0       |
| AIGSW     | Width dependence coefficient of AIGS                          | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter  | Description  | Units | Default  |
|------------|--|-------|----------|
| ALPHA0     | first parameter of Iii, m/V  | _     | 0        |
| ALPHA0L    | Length dependence coefficient of ALPHA0  | _     | 0        |
| ALPHA0LEXP | Length dependence exponent coefficient of ALPHA0   | _     | 1        |
| ASYMMOD    | 0: Asymmetry Model turned off - forward mode parameters used, 1: Asymmetry Model turned on |       | 0        |
| AT         | Temperature coefficient for saturation velocity  | _     | -0.00156 |
| ATL        | Length Scaling parameter for AT  | _     | 0        |
| BDOS       | Charge centroid parameter - slope of CV curve under QME in inversion                       | _     | 1        |
| BETA0      | Vds dependent parameter of Iii, 1/V  | _     | 0        |
| BG0SUB     | Band gap of substrate at 300.15K   | _     | 1.17     |
| BGIDL      | exponential coeff. for GIDL in   | _     | 2.3e+09  |
| BGISL      | exponential coeff. for GISL  | _     | 0        |
| BIGBACC    | Parameter for Igb  | _     | 0.00171  |
| BIGBINV    | Parameter for Igb  | _     | 0.000949 |
| BIGC       | Parameter for Igc  | _     | 0        |
| BIGD       | Parameter for Igs d  | _     | 0        |
| BIGS       | Parameter for Igs d  | _     | 0        |
| BINUNIT    | Unit of L and W for Binning, 1 : micro-meter, 0 : default                                  | _     | 1        |
| BVD        | Drain diode breakdown voltage  | _     | 0        |
| BVS        | Source diode breakdown voltage   | _     | 10       |
| CDSCB      | body-bias sensitivity of sub-threshold slope   | _     | 0        |
| CDSCBEDGE  |  | _     | 0        |
| CDSCBL     | Length dependence coefficient of CDSCB   | _     | 0        |
| CDSCBLEXP  | Length dependence exponent coefficient of CDSCB  | _     | 1        |
| CDSCD      | drain-bias sensitivity of sub-threshold slope  | _     | 1e-09    |
| CDSCDEDGE  |  | _     | 0        |
| CDSCDL     | Length dependence coefficient of CDSCD   | _     | 0        |
| CDSCDLEXP  | Length dependence exponent coefficient of CDSCD  | _     | 1        |
| CDSCDLR    | Length dependence coefficient of CDSCD   | _     | 0        |
| CDSCDR     | drain-bias sensitivity of sub-threshold slope  | _     | 0        |
| CF         | Outer Fringe Cap   | F     | 0        |
| CFRCOEFF   | Coefficient for Outer Fringe Cap   | _     | 1        |
| CGBO       | Gate - Body overlap capacitance  | _     | 0        |
| CGDL       |  | _     | 0        |
| CGDO       | Gate - Drain overlap capacitance   | _     | 0        |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter      | Description  | Units | Default |
|----------------|--|-------|---------|
| CGIDL          | exponential coeff. for GIDL in V/m   | _     | 0.5     |
| CGISL          | exponential coeff. for GISL  |       | 0       |
| CGSL           |  | _     | 0       |
| CGSO           | Gate - Source overlap capacitance  | _     | 0       |
| CIGBACC        | Parameter for Igb  | _     | 0.075   |
| CIGBINV        | Parameter for Igb  | _     | 0.006   |
| CIGC           | Parameter for Igc  | _     | 0       |
| CIGD           | Parameter for Igs d  | _     | 0       |
| CIGS           | Parameter for Igs d  | _     | 0       |
| CIT            | parameter for interface trap   | _     | 0       |
| CITEDGE        |  | _     | 0       |
| CJD            | Unit area drain-side junction capacitance at zero bias                                   | _     | 0       |
| CJS            | Unit area source-side junction capacitance at zero bias                                  | _     | 0.0005  |
| CJSWD          | Unit length drain-side sidewall junction capacitance at zero bias                        | _     | 0       |
| CJSWGD         | Unit length drain-side gate sidewall junction capacitance at zero bias                   | _     | 0       |
| CJSWGS         | Unit length source-side gate sidewall junction capacitance at zero bias                  | _     | 0       |
| CJSWS          | Unit length source-side sidewall junction capacitance at zero bias                       | _     | 5e-10   |
| CKAPPAD        |  | _     | 0.6     |
| CKAPPAS        |  | _     | 0.6     |
| COVMOD         | 0: Use Bias-independent Overlap Capacitances, 1: Use Bias-dependent Overlap Capacitances | _     | 0       |
| CTH0           | Thermal capacitance  | _     | 1e-05   |
| CVMOD          | 0: Consistent IV-CV, 1: Different IV-CV  | _     | 0       |
| DELTA          | Smoothing function factor for Vdsat  | _     | 0.125   |
| DELTAL         | Length dependence coefficient of DELTA   | _     | 0       |
| DELTALEXP      | Length dependence exponent coefficient of DELTA  | _     | 1       |
| DELVT0         |  | _     | 0       |
| DGAMMAEDGE     |  | _     | 0       |
| DGAMMAEDGEL    |  | _     | 0       |
| DGAMMAEDGELEXP |  | _     | 1       |
| DLBIN          |  | _     | 0       |
| DLC            | delta L for CV   | _     | 0       |
| DLCIG          | Delta L for Ig model [m]   | m     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DLCIGD    | Delta L for Ig model [m]                             | m     | 0       |
| DMCG      | Distance of Mid-Contact to Gate edge                 | m     | 0       |
| DMCGT     | Dist of Mid-Contact to Gate edge in Test             | m     | 0       |
| DMCI      | Distance of Mid-Contact to Isolation                 | m     | 0       |
| DMDG      | Distance of Mid-Diffusion to Gate edge               | m     | 0       |
| DSUB      | Length scaling exponent for DIBL                     | _     | 1       |
| DTEMP     | Offset of Device Temperature                         | _     | 0       |
| DTOX      | Difference between effective dielectric thickness    | _     | 0       |
| DVT0EDGE  |  | _     | 2.2     |
| DVT1EDGE  |  | _     | 0.53    |
| DVT2EDGE  | Body-bias coefficient for SCE effect for Edge FET    | _     | 0       |
| DVTEDGE   | Vth shift for Edge FET                               | _     | 0       |
| DVTP0     | DITS   | _     | 0       |
| OVTP1     | DITS   |       | 0       |
| DVTP2     | DITS   | _     | 0       |
| DVTP3     | DITS   | _     | 0       |
| OVTP4     | DITS   | _     | 0       |
| OVTP5     | DITS   | _     | 0       |
| OWBIN     |  | _     | 0       |
| DWC       | delta W for CV                                       | _     | 0       |
| DWJ       | delta W for S/D junctions                            | _     | 0       |
| EASUB     | Electron affinity of substrate                       | _     | 4.05    |
| EDGEFET   | 0: Edge FET Model Off, 1: Edge FET Model ON          | _     | 1       |
| ΞF        | Flicker Noise frequency exponent                     | _     | 1       |
| EGIDL     | band bending parameter for GIDL                      | _     | 0.8     |
| EGISL     | band bending parameter for GISL                      | _     | 0       |
| EIGBINV   | Parm for the Si bandgap for Igbinv                   | _     | 1.1     |
| EM        |  | _     | 4.1e+07 |
| EPSROX    | Relative dielectric constant of the gate dielectric  | _     | 3.9     |
| EPSRSUB   | Relative dielectric constant of the channel material | _     | 11.9    |
| ETA0      | DIBL coefficient                                     | _     | 0.08    |
| ETA0EDGE  |  | _     | 0       |
| ETA0R     | DIBL coefficient                                     | _     | 0       |
| ETAB      | Body bias coefficient for subthreshold DIBL effect   | _     | -0.07   |
| ETABEDGE  |  | _     | 0       |
| ETABEXP   | Exponent coefficient of ETAB                         | _     | 1       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| ETAMOB     | Effective field parameter (should be kept close to 1)                         |       | 1       |
| ETAQM      | Bulk charge coefficient for charge centroid in inversion                      | _     | 0.54    |
| EU         | Mobility reduction exponent   | _     | 1.5     |
| EUL        | Length dependence coefficient of EU   | _     | 0       |
| EULEXP     | Length dependence exponent coefficient of EU                                  | _     | 1       |
| EUW        | Width dependence coefficient of EU  | _     | 0       |
| EUWEXP     | Width dependence exponent coefficient of EU                                   | _     | 1       |
| EUWL       | Width-Length dependence coefficient of EU                                     | _     | 0       |
| EUWLEXP    | Width-Length dependence coefficient of EU                                     | _     | 1       |
| FPROUT     |   | _     | 0       |
| FPROUTL    | Length dependence coefficient of FPROUT                                       | _     | 0       |
| FPROUTLEXP | Length dependence exponent coefficient of FPROUT                              | _     | 1       |
| GBMIN      | Minimum body conductance  | _     | 1e-12   |
| GEOMOD     | Geo dependent parasitics model  | _     | 0       |
| GIDLMOD    | 0: Turn off GIDL Current, 1: Turn on GIDL Current                             | _     | 0       |
| IGBMOD     | 0: Turn off Igb, 1: Turn on Igb   | _     | 0       |
| IGCMOD     | 0: Turn off Igc, Igs and Igd, 1: Turn on Igc, Igs and Igd                     | _     | 0       |
| IGT        | Gate Current Temperature Dependence   | _     | 2.5     |
| IIT        | Temperature coefficient for BETA0   | _     | 0       |
| IJTHDFWD   | Forward drain diode breakdown limiting current                                | _     | 0       |
| IJTHDREV   | Reverse drain diode breakdown limiting current                                | _     | 0       |
| IJTHSFWD   | Forward source diode breakdown limiting current                               | _     | 0.1     |
| IJTHSREV   | Reverse source diode breakdown limiting current                               | _     | 0.1     |
| JSD        | Bottom drain junction reverse saturation current density                      | _     | 0       |
| JSS        | Bottom source junction reverse saturation current density                     | _     | 0.0001  |
| JSWD       | Unit length reverse saturation current for sidewall drain junction            | _     | 0       |
| JSWGD      | Unit length reverse saturation current for gate-edge sidewall drain junction  | _     | 0       |
| JSWGS      | Unit length reverse saturation current for gate-edge sidewall source junction | _     | 0       |
| JSWS       | Unit length reverse saturation current for sidewall source junction           | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| JTSD       | Bottom drain junction trap-assisted saturation current density                      | _     | 0       |
| JTSS       | Bottom source junction trap-assisted saturation current density                     | _     | 0       |
| JTSSWD     | Unit length trap-assisted saturation current for sidewall drain junction            | _     | 0       |
| JTSSWGD    | Unit length trap-assisted saturation current for gate-edge sidewall drain junction  | _     | 0       |
| JTSSWGS    | Unit length trap-assisted saturation current for gate-edge sidewall source junction | _     | 0       |
| JTSSWS     | Unit length trap-assisted saturation current for sidewall source junction           | _     | 0       |
| JTWEFF     | Trap assisted tunneling current width dependence                                    | _     | 0       |
| K1         | First-order body-bias Vth shift due to Vertical Non-uniform doping                  | _     | 0       |
| K1L        | Length dependence coefficient of K1   | _     | 0       |
| K1LEXP     | Length dependence exponent coefficient of K1  | _     | 1       |
| K1W        | Width dependence coefficient of K1  | _     | 0       |
| K1WEXP     | Width dependence exponent coefficient of K1   | _     | 1       |
| K1WL       | Width-Length dependence coefficient of K1   | _     | 0       |
| K1WLEXP    | Width-Length dependence exponent coefficient of K1                                  | _     | 1       |
| K2         | Vth shift due to Vertical Non-uniform doping  | _     | 0       |
| K2L        | Length dependence coefficient of K2   | _     | 0       |
| K2LEXP     | Length dependence exponent coefficient of K2  | _     | 1       |
| K2W        | Width dependence coefficient of K2  |       | 0       |
| K2WE       |   | _     | 0       |
| K2WEXP     | Width dependence exponent coefficient of K2   | _     | 1       |
| K2WL       | Width-Length dependence coefficient of K2   |       | 0       |
| K2WLEXP    | Width-Length dependence exponent coefficient of K2                                  | _     | 1       |
| KT1        | Temperature coefficient for Vth   | _     | -0.11   |
| KT1EDGE    |   | _     | 0       |
| KT1EXP     | Temperature coefficient for Vth   | _     | 1       |
| KT1EXPEDGE |   | _     | 0       |
| KT1L       | Temperature coefficient for Vth   | _     | 0       |
| KT1LEDGE   |   | _     | 0       |
| KT2        | Temperature coefficient for Vth   | _     | 0.022   |
| KT2EDGE    |   | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| KU0       | Mobility degradation/enhancement Parameter for<br>Stress Effect            | _     | 0       |
| KU0WE     |  | _     | 0       |
| KVSAT     | Saturation Velocity degradation/enhancement<br>Parameter for Stress Effect | _     | 0       |
| KVTH0     | Threshold Shift parameter for stress effect                                | _     | 0       |
| KVTH0WE   |  | _     | 0       |
| L         |  | m     | 1e-05   |
| LA1       |  | _     | 0       |
| LA11      |  | _     | 0       |
| LA2       |  | _     | 0       |
| LA21      |  |       | 0       |
| LAGIDL    |  |       | 0       |
| LAGISL    |  |       | 0       |
| LAIGBACC  |  |       | 0       |
| LAIGBINV  |  | _     | 0       |
| LAIGC     |  | _     | 0       |
| LAIGD     |  | _     | 0       |
| LAIGS     |  | _     | 0       |
| LALPHA0   |  | _     | 0       |
| LAT       |  | _     | 0       |
| LBETA0    |  | _     | 0       |
| LBGIDL    |  | _     | 0       |
| LBGISL    |  | _     | 0       |
| LBIGBACC  |  | _     | 0       |
| LBIGBINV  |  | _     | 0       |
| LBIGC     |  | _     | 0       |
| LBIGD     |  | _     | 0       |
| LBIGS     |  | _     | 0       |
| LCDSCB    |  | _     | 0       |
| LCDSCD    |  | _     | 0       |
| LCDSCDR   |  | _     | 0       |
| LCF       |  | F     | 0       |
| LCGDL     |  | _     | 0       |
| LCGIDL    |  | _     | 0       |
| LCGISL    |  | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| LCIGSALC         —         0           LCIGBARCC         —         0           LCIGISHINY         —         0           LCIGC         —         0           LCIGC         —         0           LCIGS         —         0           LCIT         —         0           LCKAPPAD         —         0           LCKAPPAS         —         0           LDELTA         —         0           LDEVTPO         —         0           LDVTP3         —         0           LDVTP4         —         0           LDVTP5         —         0           LEGISL         —         0           LERIAG         —         0           LETAO         —         0           LETAO         —         0  | Parameter | Description              | Units | Default |
|--|-----------|--------------------------|-------|---------|
| CIGISINV   | LCGSL     |                          | _     | 0       |
| LCIGC  LCIGS  LCIGS  LCIT  CCKAPPAD  LCKAPPAD  LCKAPPAS  LDELTA  LDELTA  LDELTA  LDELTA  LDELTA  LDUTPO  LDUTPO  LDVTP1  LDVTP2  LDVTP2  LDVTP3  LDVTP3  LDVTP3  LDVTP3  LDVTP5  LEGIBL  LDVTP4  LDVTP4  LDVTP4  LDVTP4  LDVTP5  LEGIBL  LETAD  LET | LCIGBACC  |                          | _     | 0       |
| LCIGIS  LCIT  LCIT  LCKAPPAD  LCKAPPAS  LDELTA  LDELTA  LDELTA  LDLCIG  LDLCIG  LDLCIG  LDLCIG  LDLCIG  LDLCIG  LDLCIG  LDLCIG  LDVTPO  LDVTPO  LDVTP1  LDVTP2  LDVTP3  LDVTP3  LDVTP4  LDVTP5  LDVTP5  LDVTP5  LDVTP5  LBGIBL  LBUTE  LBGIBL  LBCIG  LEIGBINV   | LCIGBINV  |                          | _     | 0       |
| LCIGS  | LCIGC     |                          | _     | 0       |
| CETT   | LCIGD     |                          | _     | 0       |
| LCKAPPAD         —         0           LCKAPPAS         —         0           LDLCIG         —         0           LDLCIGD         —         0           LDVTPO         —         0           LDVTP1         —         0           LDVTP2         —         0           LDVTP3         —         0           LDVTP4         —         0           LEGIDL         —         0           LEGISL         —         0           LEGISL         —         0           LETAO         —         0           LETAO         —         0           LETAO         —         0           LETAB         —         0           LETAB         —         0           LETAB         —         0           LEU         —         0           LITT         —         0           LITT         —         0           LINTNOI         —         0           LK2         —         0           LK2WE         —         0           LKT1         —         0           LKT2   | LCIGS     |                          | _     | 0       |
| LEAPPAS  | LCIT      |                          | _     | 0       |
| LDELTA   | LCKAPPAD  |                          | _     | 0       |
| LDLCIG  LDLCIGB  LDVTP0  LDVTP1  LDVTP1  LDVTP2  LDVTP3  LDVTP4  LDVTP5  LEGIDL  LEGIDL  LEGISL  LEGISL  LETAO  LE | LCKAPPAS  |                          | _     | 0       |
| LDLCIGD  | LDELTA    |                          | _     | 0       |
| LDVTP0   | LDLCIG    |                          | _     | 0       |
| LDVTP1   | LDLCIGD   |                          | _     | 0       |
| LDVTP2         —         0           LDVTP4         —         0           LDVTP5         —         0           LEGIDL         —         0           LEGISL         —         0           LEGISL         —         0           LETA0         —         0           LETA0R         —         0           LETAB         —         0           LEU         —         0           LETY         —         0           LIGT         —         0           LIGT         —         0           LINT         delta L for IV         —         0           LINTNOI         —         0           LK1         —         0           LK2         —         0           LK2WE         —         0           LKT1         —         0           LKT2         —         0  | LDVTP0    |                          | _     | 0       |
| LDVTP3         —         0           LDVTP5         —         0           LEGIDL         —         0           LEGISL         —         0           LEIGBINV         —         0           LETA0         —         0           LETAB         —         0           LEU         —         0           LFPROUT         —         0           LIGT         —         0           LINT         delta L for IV         —         0           LINTNOI         —         0           LK1         —         0           LK2         —         0           LK2         —         0           LK2         —         0           LK2         —         0           LK11         —         0           LK2   | LDVTP1    |                          | _     | 0       |
| LDVTP4         —         0           LDVTP5         —         0           LEGIDL         —         0           LEGISL         —         0           LETA0         —         0           LETA0R         —         0           LETAB         —         0           LEU         —         0           LFPROUT         —         0           LIGT         —         0           LIST         —         0           LINT         delta L for IV         —         0           LK1         —         0           LK2         —         0           LK2         —         0           LK2WE         —         0           LKT1         —         0           LKT2         —         0   | LDVTP2    |                          | _     | 0       |
| LDVTP5         —         0           LEGIDL         —         0           LEGISL         —         0           LETAO         —         0           LETAOR         —         0           LETAB         —         0           LEU         —         0           LFPROUT         —         0           LIGT         —         0           LIT         —         0           LINT         delta L for IV         —         0           LK1         —         0           LK2         —         0           LK2WE         —         0           LKT1         —         0           LKT2         —         0   | LDVTP3    |                          | _     | 0       |
| LEGIDL         —         0           LEGISL         —         0           LEIGBINV         —         0           LETAO         —         0           LETADR         —         0           LETAB         —         0           LEU         —         0           LFPROUT         —         0           LIGT         —         0           LIIT         —         0           LINT         delta L for IV         —         0           LK1         —         0           LK1         —         0           LK2         —         0           LK2WE         —         0           LKT1         —         0           LKT2         —         0  | LDVTP4    |                          | _     | 0       |
| LEGISL       —       0         LETAO       —       0         LETAOR       —       0         LETAB       —       0         LEU       —       0         LFPROUT       —       0         LIGT       —       0         LIIT       —       0         LINT       delta L for IV       —       0         LINTNOI       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LDVTP5    |                          | _     | 0       |
| LEIGBINV       —       0         LETAO       —       0         LETAOR       —       0         LETAB       —       0         LEU       —       0         LFPROUT       —       0         LIGT       —       0         LIIT       —       0         LINT       delta L for IV       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LEGIDL    |                          | _     | 0       |
| LETAO       —       0         LETAOR       —       0         LETAB       —       0         LEU       —       0         LFPROUT       —       0         LIGT       —       0         LITT       —       0         LINT       delta L for IV       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0   | LEGISL    |                          | _     | 0       |
| LETAOR       —       0         LEU       —       0         LFPROUT       —       0         LIGT       —       0         LINT       —       0         LINT       delta L for IV       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LK1       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0   | LEIGBINV  |                          | _     | 0       |
| LETAB       —       0         LEU       —       0         LFPROUT       —       0         LIGT       —       0         LIT       —       0         LINT       delta L for IV       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LK1       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0   | LETA0     |                          | _     | 0       |
| LEU       —       0         LFPROUT       —       0         LIGT       —       0         LINT       —       0         LINTNOI       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0         LKT2       —       0   | LETA0R    |                          | _     | 0       |
| LIFPROUT       —       0         LIGT       —       0         LIIT       —       0         LINT       delta L for IV       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LK1       —       0         LK2WE       —       0         LK11       —       0         LKT2       —       0   | LETAB     |                          | _     | 0       |
| LIGT       —       0         LINT       delta L for IV       —       0         LINTNOI       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LK11       —       0         LK12       —       0         LK11       —       0         LK12       —       0   | LEU       |                          | _     | 0       |
| LIIT       —       0         LINT       delta L for IV       —       0         LINTNOI       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0   | LFPROUT   |                          | _     | 0       |
| LINT       delta L for IV       —       0         LINTNOI       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LIGT      |                          | _     | 0       |
| LINTNOI       —       0         LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LIIT      |                          | _     | 0       |
| LK1       —       0         LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LINT      | delta L for IV           |       | 0       |
| LK2       —       0         LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LINTNOI   |                          |       | 0       |
| LK2WE       —       0         LKT1       —       0         LKT2       —       0  | LK1       |                          |       | 0       |
| LKT1 — 0<br>LKT2 — 0   | LK2       |                          |       | 0       |
| LKT2 — 0   | LK2WE     |                          |       | 0       |
|  | LKT1      |                          | _     | 0       |
| LKUO Length Dependence of KUO — 0  | LKT2      |                          | _     | 0       |
|  | LKU0      | Length Dependence of KU0 | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LKU0WE    |  | _     | 0       |
| LKVTH0    | Length dependence of KVTH0                         | _     | 0       |
| LKVTH0WE  |  | _     | 0       |
| LL        |  | _     | 0       |
| LLC       |  |       | 0       |
| LLN       |  | _     | 1       |
| LLODKU0   | Length Parameter for u0 stress effect              | _     | 0       |
| LLODVTH   | Length Parameter for Vth stress effect             | _     | 0       |
| LLONG     | L of extracted Long channel device                 | m     | 1e-05   |
| LMAX      | Maximum length for which this model should be used | m     | 100     |
| LMIN      | Minimum length for which this model should be used | m     | 0       |
| LMLT      | Length Shrinking Parameter                         | _     | 1       |
| LNDEP     |  | _     | 0       |
| LNDEPCV   |  | _     | 0       |
| LNFACTOR  |  | _     | 0       |
| LNGATE    |  | _     | 0       |
| LNIGBACC  |  | _     | 0       |
| LNIGBINV  |  | _     | 0       |
| LNSD      |  | _     | 0       |
| LNTOX     |  | _     | 0       |
| LODETA0   | eta0 modification foator for stress effect         | _     | 0       |
| LODK2     | K2 shift modification factor for stress effect     | _     | 0       |
| LP1       | Mobility channel length exponential coefficent     | _     | 1e-08   |
| LP2       | Mobility channel length exponential coefficent     | _     | 1e-08   |
| LPCLM     |  | _     | 0       |
| LPCLMCV   |  | _     | 0       |
| LPCLMR    |  | _     | 0       |
| LPDIBLC   |  | _     | 0       |
| LPDIBLCB  |  |       | 0       |
| LPDIBLCR  |  |       | 0       |
| LPDITS    |  | _     | 0       |
| LPDITSD   |  | _     | 0       |
| LPHIN     |  |       | 0       |
| LPOXEDGE  |  | _     | 0       |
| LPRT      |  | _     | 0       |
| LPRWB     |  | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| LPRWG     |             | _     | 0       |
| LPSAT     |             | _     | 0       |
| LPSATB    |             | _     | 0       |
| LPSATR    |             | _     | 0       |
| LPSCBE1   |             | _     | 0       |
| LPSCBE2   |             | _     | 0       |
| LPTWG     |             | _     | 0       |
| LPTWGR    |             | _     | 0       |
| LPTWGT    |             | _     | 0       |
| LPVAG     |             | _     | 0       |
| LRDSW     |             | _     | 0       |
| LRDSWMIN  |             | _     | 0       |
| LRDW      |             | _     | 0       |
| LRDWMIN   |             | _     | 0       |
| LRSW      |             | _     | 0       |
| LRSWMIN   |             | _     | 0       |
| LTGIDL    |             | _     | 0       |
| LU0       |             | _     | 0       |
| LU0R      |             | _     | 0       |
| LUA       |             | _     | 0       |
| LUA1      |             | _     | 0       |
| LUAR      |             | _     | 0       |
| LUC       |             | _     | 0       |
| LUC1      |             | _     | 0       |
| LUCR      |             | _     | 0       |
| LUCS      |             | _     | 0       |
| LUCSR     |             | _     | 0       |
| LUCSTE    |             | _     | 0       |
| LUD       |             | _     | 0       |
| LUD1      |             | _     | 0       |
| LUDR      |             | _     | 0       |
| LUTE      |             | _     | 0       |
| LVFB      |             | _     | 0       |
| LVFBCV    |             | _     | 0       |
| LVSAT     |             | _     | 0       |
| LVSATCV   |             | _     | 0       |
|           |             |       |         |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter   | Description   | Units             | Default |
|-------------|---|-------------------|---------|
| LVSATR      |   | _                 | 0       |
| LW          |   | _                 | 0       |
| LWC         |   | _                 | 0       |
| LWL         |   | _                 | 0       |
| LWLC        |   | _                 | 0       |
| LWN         |   | _                 | 1       |
| LWR         |   | _                 | 0       |
| LXJ         |   | _                 | 0       |
| MJD         | Drain bottom junction capacitance grading coefficient               | _                 | 0       |
| MJS         | Source bottom junction capacitance grading coefficient              | _                 | 0.5     |
| MJSWD       | Drain sidewall junction capacitance grading coefficient             | _                 | 0       |
| MJSWGD      | Drain-side gate sidewall junction capacitance grading coefficient   | _                 | 0       |
| MJSWGS      | Source-side gate sidewall junction capacitance grading coefficient  | _                 | 0       |
| MJSWS       | Source sidewall junction capacitance grading coefficient            | _                 | 0.33    |
| MOBSCALE    | Mobility scaling model, 0: Old Model, 1: New Model                  | _                 | 0       |
| MULU0       |   | _                 | 1       |
| NDEP        | Channel Doping Concentration for IV                                 | $\mathrm{m}^{-3}$ | 1e+24   |
| NDEPCV      | Channel Doping Concentration for CV                                 | $\mathrm{m}^{-3}$ | 0       |
| NDEPCVL1    | Length dependence coefficient of NDEPCV                             | _                 | 0       |
| NDEPCVL2    | Length dependence coefficient of NDEPCV - For Short Channel Devices | _                 | 0       |
| NDEPCVLEXP1 | Length dependence exponent coefficient of NDEPCV                    | —                 | 0       |
| NDEPCVLEXP2 | Length dependence exponent coefficient of NDEPCV                    | _                 | 0       |
| NDEPCVW     | Width dependence coefficient of NDEPCV                              | _                 | 0       |
| NDEPCVWEXP  | Width dependence exponent coefficient of NDEPCV                     | _                 | 0       |
| NDEPCVWL    | Width-Length dependence coefficient of NDEPCV                       | _                 | 0       |
| NDEPCVWLEXP | Width-Length dependence exponent coefficient of NDEPCV              | _                 | 0       |
| NDEPL1      | Length dependence coefficient of NDEP                               |                   | 0       |
| NDEPL2      | Length dependence of NDEP - For Short Channel Devices               | _                 | 0       |
| NDEPLEXP1   | Length dependence exponent coefficient of NDEP                      | _                 | 1       |
| NDEPLEXP2   | Length dependence exponent coefficient of NDEP                      | _                 | 2       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter    | Description   | Units             | Default   |
|--------------|---|-------------------|-----------|
| NDEPW        | Width dependence coefficient of NDEP                        |                   | 0         |
| NDEPWEXP     | Width dependence exponent coefficient of NDEP               |                   | 1         |
| NDEPWL       | Width-Length dependence coefficient of NDEP                 | _                 | 0         |
| NDEPWLEXP    | Width-Length dependence exponent coefficient of NDEP        | _                 | 1         |
| NFACTOR      | Sub-threshold slope factor                                  | _                 | 0         |
| NFACTOREDGE  |   | _                 | 0         |
| NFACTORL     | Length dependence coefficient of NFACTOR                    | _                 | 0         |
| NFACTORLEXP  | Length dependence exponent coefficient of NFACTOR           | _                 | 1         |
| NFACTORW     | Width dependence coefficient of NFACTOR                     | _                 | 0         |
| NFACTORWEXP  | Width dependence exponent coefficient of NFACTOR            | _                 | 1         |
| NFACTORWL    | Width-Length dependence coefficient of NFACTOR              | _                 | 0         |
| NFACTORWLEXP | Width-Length dependence exponent coefficient of NFACTOR     | _                 | 1         |
| NGATE        | Gate Doping Concentration                                   | $\mathrm{m}^{-3}$ | 5e+25     |
| NGCON        | Number of gate contacts                                     | _                 | 1         |
| NIOSUB       | Intrinsic carrier concentration of the substrate at 300.15K | $m^{-3}$          | 1.1e+16   |
| NIGBACC      | Parameter for Igbacc slope                                  | _                 | 1         |
| NIGBINV      | Parameter for Igbinv slope                                  |                   | 3         |
| NJD          | Drain junction emission coefficient                         | _                 | 0         |
| NJS          | Source junction emission coefficient                        | _                 | 1         |
| NJTS         | Non-ideality factor for JTSS                                | _                 | 20        |
| NJTSD        | Non-ideality factor for JTSD                                | _                 | 0         |
| NJTSSW       | Non-ideality factor for JTSSWS                              | _                 | 20        |
| NJTSSWD      | Non-ideality factor for JTSSWD                              | _                 | 0         |
| NJTSSWG      | Non-ideality factor for JTSSWGS                             | _                 | 20        |
| NJTSSWGD     | Non-ideality factor for JTSSWGD                             | _                 | 0         |
| NOIA         |   | _                 | 6.25e+40  |
| NOIB         |   | _                 | 3.125e+25 |
| NOIC         |   |                   | 8.75e+08  |
| NSD          | S/D Doping Concentration                                    | $\mathrm{m}^{-3}$ | 1e+26     |
| NTNOI        |   | _                 | 1         |
| NTOX         | Exponent for Tox ratio                                      | _                 | 1         |
| PA1          |   |                   | 0         |
| PA11         |   | _                 | 0         |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PA2       |   | _     | 0       |
| PA21      |   | _     | 0       |
| PAGIDL    |   | _     | 0       |
| PAGISL    |   | _     | 0       |
| PAIGBACC  |   | _     | 0       |
| PAIGBINV  |   | _     | 0       |
| PAIGC     |   | _     | 0       |
| PAIGD     |   | _     | 0       |
| PAIGS     |   | _     | 0       |
| PALPHA0   |   | _     | 0       |
| PAT       |   | _     | 0       |
| PBD       | Drain-side bulk junction built-in potential                           | _     | 0       |
| PBETA0    |   |       | 0       |
| PBGIDL    |   |       | 0       |
| PBGISL    |   | _     | 0       |
| PBIGBACC  |   | _     | 0       |
| PBIGBINV  |   | _     | 0       |
| PBIGC     |   | _     | 0       |
| PBIGD     |   | _     | 0       |
| PBIGS     |   | _     | 0       |
| PBS       | Source-side bulk junction built-in potential                          | _     | 1       |
| PBSWD     | Built-in potential for Drain-side sidewall junction capacitance       | _     | 0       |
| PBSWGD    | Built-in potential for Drain-side gate sidewall junction capacitance  | _     | 0       |
| PBSWGS    | Built-in potential for Source-side gate sidewall junction capacitance | _     | 0       |
| PBSWS     | Built-in potential for Source-side sidewall junction capacitance      | _     | 1       |
| PCDSCB    |   |       | 0       |
| PCDSCD    |   | _     | 0       |
| PCDSCDR   |   | _     | 0       |
| PCF       |   | F     | 0       |
| PCGDL     |   | _     | 0       |
| PCGIDL    |   | _     | 0       |
| PCGISL    |   | _     | 0       |
| PCGSL     |   |       | 0       |
|           |   |       |         |

**Table 2-113. BSIM6 Device Model Parameters** 

| FCIGBRACC         —         0           FCIGE         —         0           PCIGE         —         0           PCIGE         —         0           PCIGES         —         0           PCIT         —         0           PCKAPPAD         —         0           PCKAPPAS         —         0           PCLMC         CLM perfactor         —         0           PCLMCVL         —         0         0           PCLMCVL         —         0         0           PCLMCVLEXP         —         0         0           PCLMIG         CLM prefactor gate voltage dependence         —         0           PCLMIG         CLM prefactor gate voltage dependence         —         0           PCLMIG         Length dependence coefficient of PCLM         —         0           PCLMIG         Length dependence exponent coefficient of PCLM         —         0           PCLMIG         Length dependence exponent coefficient of PCLM         —         0           PCLMIG         CLM prefactor         —         0         0           PDLELTA         —         0         0         0         0         0   | Parameter   | Description                                      | Units | Default |
|--|-------------|--|-------|---------|
| PCIGC  | PCIGBACC    |  | _     | 0       |
| PCIGD         —         0           PCIGS         —         0           PCIT         —         0           PCKAPPAD         —         0           PCKAPPAS         —         0           PCLM         CLM prefactor         —         0           PCLMCV         CLM parameter for CV         —         0           PCLMCVL         —         0         0           PCLMCVLEXP         —         0         0           PCLMG         CLM prefactor gate voltage dependence         —         0           PCLMG         CLM prefactor         —         0           PCLMG         CLM prefactor         P.         0           PDIBLCER   | PCIGBINV    |  | _     | 0       |
| PCIT         —         0           PCIT         —         0           PCKAPPAD         —         0           PCKAPPAS         —         0           PCIM         CLM prefactor         —         0           PCIM         CLM prefactor         —         0           PCIMCV         CLM parameter for CV         —         0           PCIMCVLEXP         —         0         0           PCIMG         CLM prefactor gate voltage dependence         —         0           PCIMG         CLM prefactor         —         0           PCIMG         CLM prefactor         —         0           PCIME         CLM prefactor         —         0           PCIMR         CLM prefactor         —         0           PDIBLC         parameter for DIBL effect on Rout         —         0           PDIBLCB         parameter for DIBL effect on Rout         —         0           PDIBLCL  | PCIGC       |  | _     | 0       |
| PCIT         —         0           PCKAPPAD         —         0           PCKAPPAS         —         0           PCLM         CLM prefactor         —         0           PCLMCV         CLM parameter for CV         —         0           PCLMCVLEXP         —         0         0           PCLMCVLEXP         —         0         0           PCLMG         CLM prefactor gate voltage dependence         —         0           PCLML         Length dependence coefficient of PCLM         —         0           PCLMIR         Length dependence exponent coefficient of PCLM         —         1           PCLMR         CLM prefactor         —         0         0           PCLMR         CLM prefactor         —         0         0           PDLEATA         —         0         0         0         0           PDLEATA         —         0  | PCIGD       |  | _     | 0       |
| PCKAPPAS         —         0           PCLM         CLM prefactor         —         0           PCLMCV         CLM parameter for CV         —         0           PCLMCVL         —         0         0           PCLMCVLEXP         —         0         0           PCLMG         CLM prefactor gate voltage dependence         —         0           PDLMR         CLM prefactor         —         0           PDLMR         DPLM         —         0           PDLBLC         —         0         0           PDLBLCB         —         parameter for DIBL effect on Rout         — <td< td=""><td>PCIGS</td><td></td><td>_</td><td>0</td></td<>  | PCIGS       |  | _     | 0       |
| PCKAPPAS         —         0           PCLM         CLM prefactor         —         0           PCLMCV         CLM parameter for CV         —         0           PCLMCVLEXP         —         0           PCLMCYLEXP         —         0           PCLMG         CLM prefactor gate voltage dependence         —         0           PCLML         Length dependence coefficient of PCLM         —         0           PCLML         Length dependence exponent coefficient of PCLM         —         1           PCLMEXP         Length dependence exponent coefficient of PCLM         —         1           PCLMR         CLM prefactor         —         0         0           PCLMR         CLM prefactor         —         0         0           PDELTA         —         0         0         0         0           PDELTA         —         0  | PCIT        |  | _     | 0       |
| PCLM         CLM prefactor         —         0           PCLMCV         CLM parameter for CV         —         0           PCLMCVL         —         0         —           PCLMCVLEXP         —         0         —           PCLMG         CLM prefactor gate voltage dependence         —         0           PCLML         Length dependence coefficient of PCLM         —         0           PCLMLEXP         Length dependence exponent coefficient of PCLM         —         1           PCLMR         CLM prefactor         —         0           PDELTA         —         0         —           PDEBLTA         —         0         —           PDIBLC         parameter for DIBL effect on Rout         —         0           PDIBLCB         parameter for DIBL effect on Rout         —         0           PDIBLCLEXP         Length dependence exponent coefficient of PDIBLC         —         0           PDIBLCLEXPR         Length dependence exponent coefficient of PDIBLC         —         0           PDIBLCR         Length dependence expoficient of PDIBLC         —         0           PDIBLCR         parameter for DIBL effect on Rout         —         0           PDIBLCR   | PCKAPPAD    |  | _     | 0       |
| PCLMCV CLM parameter for CV — 0 PCLMCVL PCLMCVLEXP — 0 PCLMG CLM prefactor gate voltage dependence — 0 PCLMG CLM prefactor gate voltage dependence — 0 PCLML Length dependence coefficient of PCLM — 1 PCLMLEXP Length dependence exponent coefficient of PCLM — 1 PCLMR CLM prefactor — 0 PDELTA — 0 PDELTA — 0 PDIBLC parameter for DIBL effect on Rout — 0 PDIBLCB parameter for DIBL effect on Rout — 0 PDIBLCB Length dependence exponent coefficient of PDIBLC — 0 PDIBLCLEXP Length dependence coefficient of PDIBLC — 1 PDIBLCLEXP Length dependence exponent coefficient of PDIBLC — 1 PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC — 0 PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDIBLCR Length dependence coefficient of PDIBLC — 0 PDIBLCR Length dependence coefficient of PDIBLC — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDITS Coefficient for drain-induced Vth shifts — 0 PDITS   | PCKAPPAS    |  | _     | 0       |
| PCLMCVLEXP PCLMG CLM prefactor gate voltage dependence PCLML Length dependence coefficient of PCLM PCLMEXP Length dependence exponent coefficient of PCLM PCLMR CLM prefactor PCLMEXP PCLMEXP Length dependence exponent coefficient of PCLM PCLMR PCLMR CLM prefactor PCLMEXP PCLMR PCLMR PCLMR PCLMR PCLMR PCLM parameter for DIBL effect on Rout PCLMA PCLMR  | PCLM        | CLM prefactor                                    | _     | 0       |
| PCLIMCYLEXP PCLMG CLM prefactor gate voltage dependence PCLMI Length dependence coefficient of PCLM PCLMIEXP Length dependence exponent coefficient of PCLM PCLMR CLM prefactor PCLMR PCLMR CLM prefactor PCLMR PCLMR CLM prefactor PCLMR PCLMR CLM prefactor PCLMR  | PCLMCV      | CLM parameter for CV                             | _     | 0       |
| PCLMG       CLM prefactor gate voltage dependence       —       0         PCLML       Length dependence coefficient of PCLM       —       0         PCLMLEXP       Length dependence exponent coefficient of PCLM       —       1         PCLMR       CLM prefactor       —       0         PDELTA       —       0       0         PDIBLCA       parameter for DIBL effect on Rout       —       0         PDIBLCB       parameter for DIBL effect on Rout       —       0         PDIBLCLEXP       Length dependence coefficient of PDIBLC       —       0         PDIBLCLEXPR       Length dependence exponent coefficient of PDIBLC       —       0         PDIBLCR       Length dependence exponent coefficient of PDIBLC       —       0         PDIBLCR       Length dependence exponent coefficient of PDIBLC       —       0         PDIBLCR       parameter for DIBL effect on Rout       —       0         PDIBLCR       parameter for DIBL effect on Rout       —       0         PDITS       Coefficient for drain-induced Vth shifts       —       0         PDITSD       Vds dep of drain-induced Vth shifts       —       0         PDLCIG       —       0       0         PDVTP0 <th< td=""><td>PCLMCVL</td><td></td><td>_</td><td>0</td></th<>  | PCLMCVL     |  | _     | 0       |
| PCLML       Length dependence coefficient of PCLM       —       0         PCLMLEXP       Length dependence exponent coefficient of PCLM       —       1         PCLMR       CLM prefactor       —       0         PDELTA       —       0       0         PDIBLC       parameter for DIBL effect on Rout       —       0         PDIBLCB       parameter for DIBL effect on Rout       —       0         PDIBLCLEXP       Length dependence coefficient of PDIBLC       —       0         PDIBLCLEXPR       Length dependence exponent coefficient of PDIBLC       —       0         PDIBLCR       Length dependence coefficient of PDIBLC       —       0         PDIBLCR       parameter for DIBL effect on Rout       —       0         PDISTS       Coefficient for drain-induced Vth shifts       —       0         PDITSD       Vds dep of drain-induced Vth shifts       —       0         PDITSL       L dep of drain-induced Vth shifts       —       0         PDLCIG       —       0         PDLCIG       —       0         PDVTP0       —       0         PDVTP1       —       0         PDVTP2       —       0         PDVTP3  | PCLMCVLEXP  |  | _     | 0       |
| PCLMLEXP Length dependence exponent coefficient of PCLM  CLM prefactor  CLM prefa | PCLMG       | CLM prefactor gate voltage dependence            | _     | 0       |
| PCLMR CLM prefactor — 0 PDELTA — 0 PDELTA — 0 PDIBLC parameter for DIBL effect on Rout — 0 PDIBLCB parameter for DIBL effect on Rout — 0 PDIBLCB Length dependence coefficient of PDIBLC — 0 PDIBLCLEXP Length dependence exponent coefficient of PDIBLC — 1 PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC — 0 PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDITS Coefficient for drain-induced Vth shifts — 0 PDITSD Vds dep of drain-induced Vth shifts — 0 PDITSL L dep of drain-induced Vth shifts — 0 PDLCIG — 0 PDLCIG — 0 PDVTP0 — 0 PDVTP1 — 0 PDVTP2 — 0 PDVTP2 — 0 PDVTP3 — 0 PDVTP4 — 0 PDVTP4 — 0 PDVTP5 — 0 PDVTP5 — 0   | PCLML       | Length dependence coefficient of PCLM            | _     | 0       |
| PDELITA PDIBLC parameter for DIBL effect on Rout PDIBLCB parameter for DIBL effect on Rout PDIBLCB PDIBLCB PDIBLCCL Length dependence coefficient of PDIBLC PDIBLCLEXP Length dependence exponent coefficient of PDIBLC PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC PDIBLCLEXPR Length dependence coefficient of PDIBLC PDIBLCLEX PDIBLCLEX PDIBLCLEX POUR Length dependence coefficient of PDIBLC PDIBLCLEX POUR Length dependence coefficient of PDIBLC PDIBLCR PDITSC PDITSC PDITSC PDITSS PDITSS PDITSS PDITSS PDITSL PDITSL PDITSL PDITSL PDICIGS PDUCIGS PDUCIGS PDUTPO PDVTPO PDVTPO PDVTPO PDVTP1 PDVTP1 PDVTP2 PDVTP3 PDVTP4 PDVTP5 PDVTP6 PDVTP7 P | PCLMLEXP    | Length dependence exponent coefficient of PCLM   | _     | 1       |
| PDIBLC parameter for DIBL effect on Rout — 0 PDIBLCB parameter for DIBL effect on Rout — 0 PDIBLCL Length dependence coefficient of PDIBLC — 0 PDIBLCLEXP Length dependence exponent coefficient of PDIBLC — 1 PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC — 0 PDIBLCLEX Length dependence coefficient of PDIBLC — 0 PDIBLCR Length dependence coefficient of PDIBLC — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDITS Coefficient for drain-induced Vth shifts — 0 PDITS   | PCLMR       | CLM prefactor                                    | _     | 0       |
| PDIBLCB         parameter for DIBL effect on Rout         —         0           PDIBLCL         Length dependence coefficient of PDIBLC         —         0           PDIBLCLEXP         Length dependence exponent coefficient of PDIBLC         —         0           PDIBLCLEXPR         Length dependence exponent coefficient of PDIBLC         —         0           PDIBLCLR         Length dependence coefficient of PDIBLC         —         0           PDIBLCR         parameter for DIBL effect on Rout         —         0           PDITS         Coefficient for drain-induced Vth shifts         —         0           PDITSD         Vds dep of drain-induced Vth shifts         —         0           PDITSL         L dep of drain-induced Vth shifts         —         0           PDLCIG         —         0         0           PDVTP0         —         0         0           PDVTP1         —         0         0           PDVTP2         —         0         0           PDVTP3         —         0         0           PDVTP4         —         0         0           PDVTP5         —         0         0  | PDELTA      |  | _     | 0       |
| PDIBLCL Length dependence coefficient of PDIBLC - 0 PDIBLCLEXP Length dependence exponent coefficient of PDIBLC - 1 PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC - 0 PDIBLCLR Length dependence coefficient of PDIBLC - 0 PDIBLCR PDIBLCR PDIBLCR PARAMETER OF DIBL effect on Rout - 0 PDITS Coefficient for drain-induced Vth shifts - 0 PDITS Vds dep of drain-induced Vth shifts - 0 PDITSL L dep of drain-induced Vth shifts - 0 PDLCIG PDLCIG - 0 PDLCIGD - 0 PDVTP0 - 0 PDVTP1 - 0 PDVTP2 - 0 PDVTP3 PDVTP4 - 0 PDVTP5  | PDIBLC      | parameter for DIBL effect on Rout                | _     | 0       |
| PDIBLCLEXP Length dependence exponent coefficient of PDIBLC — 0 PDIBLCLR Length dependence exponent coefficient of PDIBLC — 0 PDIBLCLR Length dependence coefficient of PDIBLC — 0 PDIBLCR parameter for DIBL effect on Rout — 0 PDITS Coefficient for drain-induced Vth shifts — 0 PDITSD Vds dep of drain-induced Vth shifts — 0 PDITSL L dep of drain-induced Vth shifts — 0 PDLCIG — 0 PDLCIG — 0 PDLCIGD — 0 PDVTP0 — 0 PDVTP1 — 0 PDVTP2 — 0 PDVTP2 — 0 PDVTP3 — 0 PDVTP4 — 0 PDVTP4 — 0 PDVTP5 — 0 PDVTP5 — 0 PDVTP5 — 0 PDVTP6 — 0 PDVTP7 — 0   | PDIBLCB     | parameter for DIBL effect on Rout                | _     | 0       |
| PDIBLCLEXPR Length dependence exponent coefficient of PDIBLC DDIBLCLR Length dependence coefficient of PDIBLC DDIBLCR DDITS DDIBLCR DDITS DDIBLCR DDITS DDIBLCR DDITS DDIBLCR DDITS DDIBLCR DD | PDIBLCL     | Length dependence coefficient of PDIBLC          | _     | 0       |
| PDIBLCLR         Length dependence coefficient of PDIBLC         —         0           PDIBLCR         parameter for DIBL effect on Rout         —         0           PDITS         Coefficient for drain-induced Vth shifts         —         0           PDITSD         Vds dep of drain-induced Vth shifts         —         0           PDLCIG         —         0         —           PDLCIGD         —         0         —           PDVTP0         —         0         —           PDVTP1         —         0         —           PDVTP2         —         0         —           PDVTP3         —         0         —           PDVTP4         —         0         —           PDVTP5         —         0         —  | PDIBLCLEXP  | Length dependence exponent coefficient of PDIBLC | _     | 1       |
| PDIBLCR         parameter for DIBL effect on Rout         —         0           PDITS         Coefficient for drain-induced Vth shifts         —         0           PDITSD         Vds dep of drain-induced Vth shifts         —         0           PDITSL         L dep of drain-induced Vth shifts         —         0           PDLCIG         —         0         —           PDVTP0         —         0         —           PDVTP1         —         0         —           PDVTP2         —         0         —           PDVTP3         —         0         —           PDVTP4         —         0         —           PDVTP5         —         0         —  | PDIBLCLEXPR | Length dependence exponent coefficient of PDIBLC | _     | 0       |
| PDITS         Coefficient for drain-induced Vth shifts         —         0           PDITSD         Vds dep of drain-induced Vth shifts         —         0           PDITSL         L dep of drain-induced Vth shifts         —         0           PDLCIG         —         0           PDLCIGD         —         0           PDVTP0         —         0           PDVTP1         —         0           PDVTP2         —         0           PDVTP3         —         0           PDVTP4         —         0           PDVTP5         —         0  | PDIBLCLR    | Length dependence coefficient of PDIBLC          | _     | 0       |
| PDITSD         Vds dep of drain-induced Vth shifts         —         0           PDITSL         L dep of drain-induced Vth shifts         —         0           PDLCIG         —         0           PDLCIGD         —         0           PDVTP0         —         0           PDVTP1         —         0           PDVTP2         —         0           PDVTP3         —         0           PDVTP4         —         0           PDVTP5         —         0   | PDIBLCR     | parameter for DIBL effect on Rout                | _     | 0       |
| PDITSL         L dep of drain-induced Vth shifts         —         0           PDLCIG         —         0           PDVTP0         —         0           PDVTP1         —         0           PDVTP2         —         0           PDVTP3         —         0           PDVTP4         —         0           PDVTP5         —         0           PDVTP5         —         0   | PDITS       | Coefficient for drain-induced Vth shifts         | _     | 0       |
| PDLCIG       —       0         PDLCIGD       —       0         PDVTP0       —       0         PDVTP1       —       0         PDVTP2       —       0         PDVTP3       —       0         PDVTP4       —       0         PDVTP5       —       0   | PDITSD      | Vds dep of drain-induced Vth shifts              | _     | 0       |
| PDLCIGD       —       0         PDVTP0       —       0         PDVTP1       —       0         PDVTP2       —       0         PDVTP3       —       0         PDVTP4       —       0         PDVTP5       —       0  | PDITSL      | L dep of drain-induced Vth shifts                | _     | 0       |
| PDVTP0       —       0         PDVTP1       —       0         PDVTP2       —       0         PDVTP3       —       0         PDVTP4       —       0         PDVTP5       —       0  | PDLCIG      |  | _     | 0       |
| PDVTP1       —       0         PDVTP2       —       0         PDVTP3       —       0         PDVTP4       —       0         PDVTP5       —       0   | PDLCIGD     |  | _     | 0       |
| PDVTP2       —       0         PDVTP3       —       0         PDVTP4       —       0         PDVTP5       —       0  | PDVTP0      |  | _     | 0       |
| PDVTP3       —       0         PDVTP4       —       0         PDVTP5       —       0   | PDVTP1      |  | _     | 0       |
| PDVTP4       —       0         PDVTP5       —       0  | PDVTP2      |  | _     | 0       |
| PDVTP5 — 0   | PDVTP3      |  | _     | 0       |
|  | PDVTP4      |  | _     | 0       |
| PEGIDL — 0   | PDVTP5      |  | _     | 0       |
|  | PEGIDL      |  | _     | 0       |

Table 2-113. BSIM6 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PEGISL    |   | _     | 0       |
| PEIGBINV  |   | _     | 0       |
| PERMOD    | Whether PS/PD (when given) include gate-edge perimeter    | _     | 1       |
| PETA0     |   |       | 0       |
| PETAOR    |   | _     | 0       |
| PETAB     |   | _     | 0       |
| PEU       |   | _     | 0       |
| PFPROUT   |   | _     | 0       |
| PHIN      | Nonuniform vertical doping effect on surface potential, V | V     | 0.045   |
| PIGCD     | Igc, S/D partition parameter                              | _     | 1       |
| PIGCDL    | Length dependence coefficient of PIGCD                    |       | 0       |
| PIGT      |   | _     | 0       |
| PIIT      |   | _     | 0       |
| PK1       |   | _     | 0       |
| PK2       |   | _     | 0       |
| PK2WE     |   | _     | 0       |
| PKT1      |   | _     | 0       |
| PKT2      |   | _     | 0       |
| PKU0      | Cross Term Dependence of KU0                              | _     | 0       |
| PKU0WE    |   | _     | 0       |
| PKVTH0    | Cross-term dependence of KVTH0                            | _     | 0       |
| PKVTH0WE  |   | _     | 0       |
| PNDEP     |   | _     | 0       |
| PNDEPCV   |   | _     | 0       |
| PNFACTOR  |   | _     | 0       |
| PNGATE    |   | _     | 0       |
| PNIGBACC  |   | _     | 0       |
| PNIGBINV  |   | _     | 0       |
| PNSD      |   | _     | 0       |
| PNTOX     |   | _     | 0       |
| POXEDGE   | Factor for the gate edge Tox                              | _     | 1       |
| PPCLM     |   | _     | 0       |
| PPCLMCV   |   |       | 0       |
| PPCLMR    |   | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description                                      | Units | Default |
|-----------|--|-------|---------|
| PPDIBLC   |  | _     | 0       |
| PPDIBLCB  |  | _     | 0       |
| PPDIBLCR  |  | _     | 0       |
| PPDITS    |  |       | 0       |
| PPDITSD   |  | _     | 0       |
| PPHIN     |  | _     | 0       |
| PPOXEDGE  |  | _     | 0       |
| PPRT      |  | _     | 0       |
| PPRWB     |  | _     | 0       |
| PPRWG     |  | _     | 0       |
| PPSAT     |  | _     | 0       |
| PPSATB    |  | _     | 0       |
| PPSATR    |  | _     | 0       |
| PPSCBE1   |  |       | 0       |
| PPSCBE2   |  | _     | 0       |
| PPTWG     |  |       | 0       |
| PPTWGR    |  | _     | 0       |
| PPTWGT    |  | _     | 0       |
| PPVAG     |  |       | 0       |
| PRDSW     |  | _     | 0       |
| PRDSWMIN  |  | _     | 0       |
| PRDW      |  | _     | 0       |
| PRDWMIN   |  | _     | 0       |
| PRSW      |  |       | 0       |
| PRSWMIN   |  | _     | 0       |
| PRT       | Temperature coefficient for resistance           | _     | 0       |
| PRWB      | Body bias dependence of resistance               | _     | 0       |
| PRWBL     | Length dependence coefficient of PPRWB           | _     | 0       |
| PRWBLEXP  | Length dependence exponent coefficient of PPRWB  | _     | 1       |
| PRWG      | gate bias dependence of S/D extension resistance | _     | 1       |
| PSAT      | Gmsat variation with gate bias                   | _     | 1       |
| PSATB     | Body bias effect on Idsat                        | _     | 0       |
| PSATL     |  | _     | 0       |
| PSATLEXP  |  | _     | 1       |
| PSATR     | Gmsat variation with gate bias                   | _     | 0       |
| PSATX     |  | _     | 1       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| PSCBE1    | Substrate current body-effect coeff                             | _     | 4.24e+08 |
| PSCBE2    | Substrate current body-effect coeff                             | _     | 1e-08    |
| PTGIDL    |   | _     | 0        |
| PTWG      | Idsat variation with gate bias                                  | _     | 0        |
| PTWGL     | Length dependence coefficient of PTWG                           | _     | 0        |
| PTWGLEXP  | Length dependence exponent coefficient of PTWG                  | _     | 1        |
| PTWGLEXPR | Length dependence exponent coefficient of PTWG                  | _     | 0        |
| PTWGLR    | Length dependence coefficient of PTWG                           | _     | 0        |
| PTWGR     | Idsat variation with gate bias                                  | _     | 0        |
| PTWGT     | Temperature coefficient for PTWG                                | _     | 0        |
| PTWGTL    | Length Scaling parameter for PTWGT                              | _     | 0        |
| PU0       |   | _     | 0        |
| PU0R      |   | _     | 0        |
| PUA       |   | _     | 0        |
| PUA1      |   | _     | 0        |
| PUAR      |   | _     | 0        |
| PUC       |   | _     | 0        |
| PUC1      |   | _     | 0        |
| PUCR      |   | _     | 0        |
| PUCS      |   | _     | 0        |
| PUCSR     |   | _     | 0        |
| PUCSTE    |   | _     | 0        |
| PUD       |   | _     | 0        |
| PUD1      |   | _     | 0        |
| PUDR      |   | _     | 0        |
| PUTE      |   | _     | 0        |
| PVAG      | Vg dependence of early voltage                                  | _     | 1        |
| PVFB      |   | _     | 0        |
| PVFBCV    |   | _     | 0        |
| PVSAT     |   | _     | 0        |
| PVSATCV   |   | _     | 0        |
| PVSATR    |   | _     | 0        |
| PWR       |   | _     | 0        |
| PXJ       |   | _     | 0        |
| QM0       | Charge centroid parameter - starting point for QME in inversion | _     | 0.001    |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| RBDB      | Resistance between bNode and dbNode   |       | 50      |
| RBDBX0    | Scaling prefactor for RBDBX   | _     | 100     |
| RBDBY0    | Scaling prefactor for RBDBY   | _     | 100     |
| RBODYMOD  | Distributed body R model  | _     | 0       |
| RBPB      | Resistance between bNodePrime and bNode   | _     | 50      |
| RBPBX0    |   | _     | 100     |
| RBPBXL    | Length Scaling parameter for RBPBX  | _     | 0       |
| RBPBXNF   | Number of fingers Scaling parameter for RBPBX   | _     | 0       |
| RBPBXW    | Width Scaling parameter for RBPBX   | _     | 0       |
| RBPBY0    | Scaling prefactor for RBPBY   | _     | 100     |
| RBPBYL    | Length Scaling parameter for RBPBY  | _     | 0       |
| RBPBYNF   | Number of fingers Scaling parameter for RBPBY   | _     | 0       |
| RBPBYW    | Width Scaling parameter for RBPBY   | _     | 0       |
| RBPD      | Resistance between bNodePrime and bNode   | _     | 50      |
| RBPD0     |   | _     | 50      |
| RBPDL     | Length Scaling parameter for RBPD   | _     | 0       |
| RBPDNF    | Number of fingers Scaling parameter for RBPD  | _     | 0       |
| RBPDW     | Width Scaling parameter for RBPD  | _     | 0       |
| RBPS      | Resistance between bNodePrime and sbNode  |       | 50      |
| RBPS0     | Scaling prefactor for RBPS 50 Ohms  | _     | 50      |
| RBPSL     |   | _     | 0       |
| RBPSNF    |   | _     | 0       |
| RBPSW     |   | _     | 0       |
| RBSB      | Resistance between bNode and sbNode   | _     | 50      |
| RBSBX0    | Scaling prefactor for RBSBX   | _     | 100     |
| RBSBY0    | Scaling prefactor for RBSBY   | _     | 100     |
| RBSDBXL   | Length Scaling parameter for RBSBX and RBDBX  | _     | 0       |
| RBSDBXNF  | Number of fingers Scaling parameter for RBSBX and RBDBX   | _     | 0       |
| RBSDBXW   | Width Scaling parameter for RBSBX and RBDBX   | _     | 0       |
| RBSDBYL   | Length Scaling parameter for RBSBY and RBDBY  | _     | 0       |
| RBSDBYNF  | Number of fingers Scaling parameter for RBSBY and RBDBY   | _     | 0       |
| RBSDBYW   | Width Scaling parameter for RBSBY and RBDBY   | _     | 0       |
| RDSMOD    | 0: Internal bias dependent and external bias independent s/d resistance model, 1: External s/d resistance model | _     | 0       |

Table 2-113. BSIM6 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| RDSW      | zero bias Resistance (RDSMOD=0 and RDSMOD=2)                          | _     | 20      |
| RDSWL     | Geometrical scaling of RDSW (RDSMOD=0 and RDSMOD=2)                   | _     | 0       |
| RDSWLEXP  | Geometrical scaling of RDSW (RDSMOD=0 and RDSMOD=2)                   | _     | 1       |
| RDSWMIN   | S/D Resistance per unit width at high Vgs (RDSMOD=0 and RDSMOD=2)     | _     | 0       |
| RDW       | zero bias Drain Resistance (RDSMOD=1)                                 | _     | 0       |
| RDWL      | Geometrical scaling of RDW (RDSMOD=1)                                 | _     | 0       |
| RDWLEXP   | Geometrical scaling of RDW (RDSMOD=1)                                 | _     | 0       |
| RDWMIN    | Drain Resistance per unit width at high Vgs (RDSMOD=1)                | _     | 0       |
| RGATEMOD  | Gate resistance model selector  | _     | 0       |
| RGEOMOD   | Geometry-dependent source/drain resistance, 0: RSH-based, 1: Holistic | _     | 0       |
| RNOIA     | TNOIMOD = 1   |       | 0.577   |
| RNOIB     | TNOIMOD = 1   | _     | 0.5164  |
| RNOIC     | TNOIMOD = 1   | _     | 0.395   |
| RSH       | Source-drain sheet resistance   | _     | 0       |
| RSHG      | Gate sheet resistance   | _     | 0.1     |
| RSW       | zero bias Source Resistance (RDSMOD=1)                                | _     | 10      |
| RSWL      | Geometrical scaling of RSW (RDSMOD=1)                                 | _     | 0       |
| RSWLEXP   | Geometrical scaling of RSW (RDSMOD=1)                                 | _     | 1       |
| RSWMIN    | Source Resistance per unit width at high Vgs (RDSMOD=1)               | _     | 0       |
| RTH0      | Thermal resistance  | _     | 0       |
| SA        | Distance between OD edge from Poly from one side                      | _     | 0       |
| SAREF     | Reference distance between OD edge from Poly from one side            | _     | 1e-06   |
| SB        | Distance between OD edge from Poly from other side                    | _     | 0       |
| SBREF     | Reference distance between OD edge from Poly from other side          | _     | 1e-06   |
| SC        | Distance to a single well edge if <=0.0, turn off WPE                 |       | 0       |
| SCA       |   | _     | 0       |
| SCB       |   | _     | 0       |
| SCC       |   | _     | 0       |
| SCREF     |   | _     | 1e-06   |
| SD        | Distance between neighboring fingers                                  | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter    | Description   | Units | Default  |
|--------------|---|-------|----------|
| SHMOD        | 0 : Self heating model OFF, 1 : Self heating model ON                                   | _     | 0        |
| STETA0       | eta0 shift related to Vth0 change   |       | 0        |
| STK2         | K2 shift factor related to Vth change   | _     | 0        |
| TBGASUB      | Bandgap Temperature Coefficient   | _     | 0.000473 |
| TBGBSUB      | Bandgap Temperature Coefficient   | _     | 636      |
| TCJ          | Temperature coefficient for CJS/CJD   |       | 0        |
| TCJSW        | Temperature coefficient for CJSWS/CJSWD   | _     | 0        |
| TCJSWG       | Temperature coefficient for CJSWGS/CJSWGD   | _     | 0        |
| TDELTA       | Temperature coefficient for DELTA   | _     | 0        |
| TETA0        | Temperature coefficient for ETA0  | _     | 0        |
| TETA0EDGE    |   | _     | 0        |
| TGIDL        | Temperature coefficient for GIDL/GISL   |       | 0        |
| TKU0         | Temperature Coefficient for KU0   | _     | 0        |
| TNFACTOR     | Temperature exponent for NFACTOR  | _     | 0        |
| TNFACTOREDGE |   | _     | 0        |
| TNJTS        | Temperature coefficient for NJTS  | _     | 0        |
| TNJTSD       | Temperature coefficient for NJTSD   | _     | 0        |
| TNJTSSW      | Temperature coefficient for NJTSSW  | _     | 0        |
| TNJTSSWD     | Temperature coefficient for NJTSSWD   | _     | 0        |
| TNJTSSWG     | Temperature coefficient for NJTSSWG   | _     | 0        |
| TNJTSSWGD    | Temperature coefficient for NJTSSWGD  | _     | 0        |
| TNOIA        | TNOIMOD = 1   |       | 0        |
| TNOIB        | TNOIMOD = 1   | _     | 0        |
| TNOIC        | Correlation coefficient   | _     | 0        |
| TNOIMOD      | Thermal noise model selector  | _     | 0        |
| TNOM         | Temperature at which the model was extracted  |       | 27       |
| TOXE         | Effective gate dielectric thickness relative to SiO2, m                                 | m     | 3e-09    |
| TOXP         | Physical gate dielectric thickness, If not given, TOXP is calculated from TOXE and DTOX | m     | 0        |
| TOXREF       | Target tox value  | m     | 3e-09    |
| TPB          | Temperature coefficient for PBS/PBD   | _     | 0        |
| TPBSW        | Temperature coefficient for PBSWS/PBSWD   | _     | 0        |
| TPBSWG       | Temperature coefficient for PBSWGS/PBSWGD   | _     | 0        |
| TYPE         |   | _     | 1        |
| U0           |   |       | 0.067    |
| UOL          | Length dependence coefficient of U0L  | _     | 0        |

**Table 2-113. BSIM6 Device Model Parameters** 

| UOLEXEP         Length dependence exponent coefficient of UOL         —         0           UOR         Mobility reduction coefficient         —         0.001           UAL         Temperature coefficient for UA         —         0.001           UAL         Length Scaling parameter for UA1         —         0           UAL         Length dependence exponent coefficient of UA         —         1           UAR         Mobility reduction coefficient of UA         —         1           UAW         Width dependence exponent coefficient of UA         —         0           UAW         Width dependence exponent coefficient of UA         —         1           UAW         Width-Length dependence coefficient of UA         —         0           UAW         Width-Length dependence coefficient of UA         —         1           UAW         Width-Length dependence coefficient of UA         —         1           UCA         Mobility reduction with body bias         —         0           UCI         Length dependence coefficient of UC         —         0           UCI         Length dependence cexponent coefficient of UC         —         0           UCI         Length dependence cexponent coefficient of UC         —         0 <tr< th=""><th>Parameter</th><th>Description</th><th>Units</th><th>Default</th></tr<>   | Parameter | Description  | Units | Default   |
|--|-----------|--|-------|-----------|
| UA         Mobility reduction coefficient         —         0.001           UA1         Temperature coefficient for UA         —         0.001           UAL         Length Scaling parameter for UA1         —         0           UAL         Length dependence coefficient of UA         —         0           UALEXP         Length dependence exponent coefficient of UA         —         0           UAR         Mobility reduction coefficient of UA         —         0           UAW         Width dependence exponent coefficient of UA         —         1           UAW         Width Length dependence coefficient of UA         —         0           UAWL         Width-Length dependence coefficient of UA         —         1           UAWL         Width-Length dependence coefficient of UA         —         1           UCC         Mobility reduction with body bias         —         0           UCI         Length dependence coefficient of UC         —         0           UCI         Length dependence coefficient of UC         —         0           UCI         Length dependence exponent coefficient of UC         —         0           UCS         Coulombic scattering parameter         —         0           UCS <td< td=""><td>UOLEXP</td><td>Length dependence exponent coefficient of U0L</td><td>_</td><td>1</td></td<>  | UOLEXP    | Length dependence exponent coefficient of U0L      | _     | 1         |
| UA1 Temperature coefficient for UA   | UOR       |  | _     | 0         |
| UAIL         Length Scaling parameter for UA         —         0           UAL         Length dependence coefficient of UA         —         0           UALEXP         Length dependence exponent coefficient of UA         —         1           UAR         Mobility reduction coefficient of UA         —         0           UAW         Width dependence exponent coefficient of UA         —         0           UAWLEXP         Width Length dependence coefficient of UA         —         0           UAWLEXP         Width-Length dependence coefficient of UA         —         0           UAWLEXP         Width-Length dependence coefficient of UA         —         0           UCA         Mobility reduction with body bias         —         0           UC1         Temperature coefficient for UC         —         0           UC1         Length dependence coefficient of UC         —         0           UC2         Mobility reduction with body bias         —         0           UC3         Coulombic scattering parameter         —         2           UC5         Coulombic scattering parameter         —         0           UC5         Coulombic scattering parameter         —         0         0           UC5  | UA        | Mobility reduction coefficient                     | _     | 0.001     |
| UAL         Length dependence coefficient of UA         —         0           UALEXP         Length dependence exponent coefficient of UA         —         1           UAR         Mobility reduction coefficient         —         0           UAW         Width dependence exponent coefficient of UA         —         0           UAWL         Width dependence exponent coefficient of UA         —         1           UAWL         Width-Length dependence coefficient of UA         —         0           UAWLEXP         Width-Length dependence coefficient of UA         —         1           UC         Mobility reduction with body bias         —         0           UC1         Temperature coefficient of UC         —         0           UC2         Length dependence exponent coefficient of UC         —         1           UC3         Length dependence exponent coefficient of UC         —         0           UC4         Length dependence exponent coefficient of UC         —         1           UC5         Coulombic scattering parameter         —         2           UC5         Temperature coefficient of UC         —         0           UC6         Width dependence exponent coefficient of UC         —         0           UC   | UA1       | Temperature coefficient for UA                     | _     | 0.001     |
| UALEXP         Length dependence exponent coefficient of UA         —         1           UAR         Mobility reduction coefficient         —         0           UAW         Width dependence coefficient of UA         —         0           UAWEXP         Width dependence exponent coefficient of UA         —         1           UAWL         Width-Length dependence coefficient of UA         —         0           UAWLEXP         Width-Length dependence coefficient of UA         —         1           UC         Mobility reduction with body bias         —         0           UC1         Temperature coefficient of UC         —         5.6e-11           UC2         Length dependence coefficient of UC         —         0           UC3         Columbic scattering parameter         —         0           UC5         Coulombic scattering parameter         —         2           UC5         Coulombic scattering parameter         —         0           UC5         Coulombic scattering parameter         —         0           UC5         Temperature coefficient of UC         —         0           UC6         Width dependence exponent coefficient of UC         —         0           UC7         Width-Length dependence e  | UA1L      | Length Scaling parameter for UA1                   | _     | 0         |
| UAR       Mobility reduction coefficient       —       0         UAW       Width dependence coefficient of UA       —       0         UAWLEXP       Width dependence exponent coefficient of UA       —       1         UAWL       Width-Length dependence coefficient of UA       —       0         UAWLEXP       Width-Length dependence coefficient of UA       —       1         UC       Mobility reduction with body bias       —       0         UC1       Temperature coefficient for UC       —       5.6e-11         UCL       Length dependence coefficient of UC       —       0         UCL       Length dependence exponent coefficient of UC       —       0         UCR       Mobility reduction with body bias       —       0         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       0         UCS       Coulombic scattering parameter       —       0         UCS       Coulombic scattering parameter       —       0         UCW       Width dependence exponent coefficient of UC       —       0         UCWL       Width-Length dependence exponent coefficient of UC       —       1         UCWL  | UAL       | Length dependence coefficient of UA                | _     | 0         |
| UAW         Width dependence coefficient of UA         —         0           UAWEXP         Width dependence exponent coefficient of UA         —         1           UAWIL         Width-Length dependence coefficient of UA         —         0           UAWLEXP         Width-Length dependence coefficient of UA         —         1           UC         Mobility reduction with body bias         —         0           UC1         Temperature coefficient for UC         —         0.6e-11           UCL         Length dependence coefficient of UC         —         0           UCLEXP         Length dependence exponent coefficient of UC         —         0           UCR         Mobility reduction with body bias         —         0           UCS         Coulombic scattering parameter         —         0           UCS         Coulombic scattering parameter         —         0           UCSR         Coulombic scattering parameter         —         0           UCW         Width dependence exponent coefficient of UC         —         1           UCW         Width-Length dependence exponent coefficient of UC         —         1           UCWLEXP         Width-Length dependence exponent coefficient of UC         —         1  | UALEXP    | Length dependence exponent coefficient of UA       | _     | 1         |
| UAWEXP       Width dependence exponent coefficient of UA       —       1         UAWL       Width-Length dependence coefficient of UA       —       0         UAWLEXP       Width-Length dependence coefficient of UA       —       1         UC       Mobility reduction with body bias       —       0         UC1       Temperature coefficient of UC       —       0         UCL       Length dependence exponent coefficient of UC       —       0         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       2         UCSR       Coulombic scattering parameter       —       0         UCSR       Coulombic scattering parameter       —       0         UCSR       Coulombic scattering parameter       —       0         UCW       Width dependence coefficient of UC       —       0         UCW       Width dependence coefficient of UC       —       0         UCWL       Width-Length dependence coefficient of UC       —       1         UCWL       Width-Length dependence exponent coefficient of UC       —       0         UD       Coulombic scattering parameter       —       0.001         UD1  | UAR       | Mobility reduction coefficient                     | _     | 0         |
| UAWIL       Width-Length dependence coefficient of UA       —       0         UAWLEXP       Width-Length dependence coefficient of UA       —       1         UC       Mobility reduction with body bias       —       0         UC1       Temperature coefficient for UC       —       5.6e-11         UCL       Length dependence coefficient of UC       —       0         UCLEXP       Length dependence exponent coefficient of UC       —       1         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       0         UCSR       Coulombic scattering parameter       —       0         UCSTE       Temperature coefficient for UCS       —       -0.004775         UCW       Width dependence coefficient of UC       —       0         UCWLEXP       Width dependence exponent coefficient of UC       —       1         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Length dependence coefficient of UD       —       0         U  | UAW       | Width dependence coefficient of UA                 | _     | 0         |
| UAWLEXP       Width-Length dependence coefficient of UA       —       1         UC       Mobility reduction with body bias       —       0         UC1       Temperature coefficient for UC       —       5.6e-11         UCL       Length dependence coefficient of UC       —       0         UCLEXP       Length dependence exponent coefficient of UC       —       1         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       0         UCSR       Coulombic scattering parameter       —       0         UCSR       Coulombic scattering parameter       —       0         UCW       Width dependence coefficient of UC       —       0         UCW       Width dependence exponent coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD       Coulombic scattering parameter       —       0.001         UDL       Length dependence coefficient of UD       —       0         UDL       Length dependence exponent coefficient of UD       —       0         UDR  | UAWEXP    | Width dependence exponent coefficient of UA        | _     | 1         |
| UC       Mobility reduction with body bias       —       0         UC1       Temperature coefficient for UC       —       5.6e-11         UCL       Length dependence coefficient of UC       —       0         UCLEXP       Length dependence exponent coefficient of UC       —       1         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       2         UCSR       Coulombic scattering parameter       —       0         UCSR       Coulombic scattering parameter       —       0.004775         UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width dependence exponent coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       0         UD       Coulombic scattering parameter       —       0.001         UD       Coulombic scattering parameter for UD       —       0         UDL       Length Scaling parameter for UD       —       0         UDL       Length dependence exponent coefficient of UD       —       0         UDL       Length dependence exponent coefficient of UD       —       0         UDA  | UAWL      | Width-Length dependence coefficient of UA          | _     | 0         |
| UC1       Temperature coefficient for UC       —       5.6e-11         UCL       Length dependence coefficient of UC       —       0         UCLEXP       Length dependence exponent coefficient of UC       —       1         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       2         UCSR       Coulombic scattering parameter       —       0         UCSTE       Temperature coefficient for UCS       —       -0.004775         UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width dependence exponent coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Length dependence coefficient of UD       —       0         UDL       Length dependence exponent coefficient of UD       —       1         UDR       Coulombic scattering parameter       —       0   | UAWLEXP   | Width-Length dependence coefficient of UA          |       | 1         |
| Length dependence coefficient of UC — 0 UCLEXP Length dependence exponent coefficient of UC — 1 UCR Mobility reduction with body bias — 0 UCS Coulombic scattering parameter — 2 UCSR Coulombic scattering parameter — 0 UCSTE Temperature coefficient for UCS — 0.004775 UCW Width dependence exponent coefficient of UC — 0 UCWEXP Width dependence exponent coefficient of UC — 1 UCWL Width-Length dependence coefficient of UC — 1 UCWL Width-Length dependence exponent coefficient of UC — 1 UDD Coulombic scattering parameter — 0.0001 UDD1 Temperature coefficient for UD — 0 UDD1 Length Scaling parameter — 0.0001 UDD1 Length dependence coefficient of UD — 0 UDD1 Length dependence coefficient of UD — 0 UDD1 Length dependence coefficient of UD — 0 UDD2 Length dependence coefficient of UD — 0 UDD4 Length dependence coefficient of UD — 0 UDD5 Length dependence exponent coefficient of UD — 1 UDD6 Mobility channel length coefficent — 0 UTF1 Mobility channel length coefficent — 0 UTF2 Mobility channel length coefficent — 0 UTFE Mobility temperature exponent — -1.5 UTEL Length Scaling parameter for UTE — 0 VFB Flat band voltage V — -0.5 | UC        | Mobility reduction with body bias                  | _     | 0         |
| UCLEXP       Length dependence exponent coefficient of UC       —       1         UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       2         UCSR       Coulombic scattering parameter       —       0         UCSTE       Temperature coefficient for UCS       —       -0.004775         UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width dependence exponent coefficient of UC       —       1         UCWL       Width-Length dependence coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Length Scaling parameter for UD1       —       0         UDL       Length dependence coefficient of UD       —       0         UDL       Length dependence exponent coefficient of UD       —       0         UDR       Coulombic scattering parameter       —       0         UD2       Mobility channel length coefficient       —       0         UTE   | UC1       | Temperature coefficient for UC                     | _     | 5.6e-11   |
| UCR       Mobility reduction with body bias       —       0         UCS       Coulombic scattering parameter       —       2         UCSR       Coulombic scattering parameter       —       0         UCSTE       Temperature coefficient for UCS       —       -0.004775         UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width-Length dependence exponent coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Temperature coefficient of UD       —       0         UD1       Length Scaling parameter for UD1       —       0         UDLEXP       Length dependence coefficient of UD       —       0         UDR       Coulombic scattering parameter       —       0         UDR       Coulombic scattering parameter       —       0         UP1       Mobility channel length coefficient of UD       —       1         UD2       Mobility channel length coefficent       —       0         UTE       Mobility channe   | UCL       | Length dependence coefficient of UC                | _     | 0         |
| UCS       Coulombic scattering parameter       —       2         UCSR       Coulombic scattering parameter       —       0         UCSTE       Temperature coefficient for UCS       —       -0.004775         UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width dependence exponent coefficient of UC       —       1         UCWL       Width-Length dependence coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Length Scaling parameter for UD1       —       0         UDL       Length dependence coefficient of UD       —       0         UDL       Length dependence exponent coefficient of UD       —       1         UDR       Coulombic scattering parameter       —       0         UP1       Mobility channel length coefficient       —       0         UP2       Mobility channel length coefficent       —       0         UTE       Mobility temperature exponent       —       -1.5         UTE       Lengt   | UCLEXP    | Length dependence exponent coefficient of UC       | _     | 1         |
| UCSR       Coulombic scattering parameter       —       0         UCSTE       Temperature coefficient for UCS       —       -0.004775         UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width dependence exponent coefficient of UC       —       0         UCWL       Width-Length dependence coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.0001         UD1       Temperature coefficient for UD       —       0         UD1       Length Scaling parameter for UD1       —       0         UDL       Length dependence coefficient of UD       —       0         UDL       Length dependence exponent coefficient of UD       —       1         UDR       Coulombic scattering parameter       —       0         UDP       Mobility channel length coefficient       —       0         UP2       Mobility channel length coefficent       —       0         UTE       Mobility temperature exponent       —       -1.5         UTE       Length Scaling parameter for UTE       —       0         VFB       Fl   | UCR       | Mobility reduction with body bias                  |       | 0         |
| Temperature coefficient for UCS — -0.004775  UCW Width dependence coefficient of UC — 0  UCWEXP Width dependence exponent coefficient of UC — 1  UCWL Width-Length dependence coefficient of UC — 0  UCWLEXP Width-Length dependence exponent coefficient of UC — 1  UD Coulombic scattering parameter — 0.001  UD1 Temperature coefficient for UD — 0  UD1L Length Scaling parameter for UD1 — 0  UDLEXP Length dependence coefficient of UD — 0  UDLEXP Length dependence coefficient of UD — 0  UDLEXP Length dependence exponent coefficient of UD — 1  UDR Coulombic scattering parameter — 0  UP1 Mobility channel length coefficient — 0  UP2 Mobility channel length coefficent — 0  UTE Mobility temperature exponent — -1.5  UTEL Length Scaling parameter for UTE — 0  VFB Flat band voltage V — -0.5   | UCS       | Coulombic scattering parameter                     |       | 2         |
| UCW       Width dependence coefficient of UC       —       0         UCWEXP       Width dependence exponent coefficient of UC       —       1         UCWL       Width-Length dependence coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Length Scaling parameter for UD1       —       0         UDL       Length dependence coefficient of UD       —       0         UDR       Coulombic scattering parameter       —       0         UDR       Coulombic scattering parameter       —       0         UP1       Mobility channel length coefficient       —       0         UP2       Mobility channel length coefficent       —       0         UTE       Mobility temperature exponent       —       -1.5         UTEL       Length Scaling parameter for UTE       —       0         VFB       Flat band voltage       V       -0.5   | UCSR      | Coulombic scattering parameter                     | _     | 0         |
| Width dependence exponent coefficient of UC — 1 UCWL Width-Length dependence coefficient of UC — 0 UCWLEXP Width-Length dependence exponent coefficient of UC — 1 UD Coulombic scattering parameter — 0.001 UD1 Temperature coefficient for UD — 0 UD1L Length Scaling parameter for UD1 — 0 UDLEXP Length dependence coefficient of UD — 0 UDLEXP Length dependence coefficient of UD — 1 UDR Coulombic scattering parameter — 0 UP1 Mobility channel length coefficient of UD — 1 UDR Mobility channel length coefficent — 0 UP2 Mobility channel length coefficent — 0 UTE Mobility temperature exponent — -1.5 UTEL Length Scaling parameter for UTE — 0 VFB Flat band voltage V -0.5  | UCSTE     | Temperature coefficient for UCS                    | _     | -0.004775 |
| UCWL       Width-Length dependence coefficient of UC       —       0         UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1       Length Scaling parameter for UD1       —       0         UDL       Length dependence coefficient of UD       —       0         UDR       Length dependence exponent coefficient of UD       —       1         UDR       Coulombic scattering parameter       —       0         UP1       Mobility channel length coefficient       —       0         UP2       Mobility channel length coefficent       —       0         UTE       Mobility temperature exponent       —       -1.5         UTEL       Length Scaling parameter for UTE       —       0         VFB       Flat band voltage       V       -0.5   | UCW       | Width dependence coefficient of UC                 | _     | 0         |
| UCWLEXP       Width-Length dependence exponent coefficient of UC       —       1         UD       Coulombic scattering parameter       —       0.001         UD1       Temperature coefficient for UD       —       0         UD1L       Length Scaling parameter for UD1       —       0         UDL       Length dependence coefficient of UD       —       0         UDR       Length dependence exponent coefficient of UD       —       1         UDR       Coulombic scattering parameter       —       0         UP1       Mobility channel length coefficent       —       0         UP2       Mobility channel length coefficent       —       0         UTE       Mobility temperature exponent       —       -1.5         UTEL       Length Scaling parameter for UTE       —       0         VFB       Flat band voltage       V       -0.5  | UCWEXP    | Width dependence exponent coefficient of UC        | _     | 1         |
| UD Coulombic scattering parameter — 0.001  UD1 Temperature coefficient for UD — 0  UD1L Length Scaling parameter for UD1 — 0  UDL Length dependence coefficient of UD — 0  UDLEXP Length dependence exponent coefficient of UD — 1  UDR Coulombic scattering parameter — 0  UP1 Mobility channel length coefficent — 0  UP2 Mobility channel length coefficent — 0  UTE Mobility temperature exponent — -1.5  UTEL Length Scaling parameter for UTE — 0  VFB Flat band voltage V -0.5  | UCWL      | Width-Length dependence coefficient of UC          | _     | 0         |
| UD1 Temperature coefficient for UD — 0  UD1L Length Scaling parameter for UD1 — 0  UDL Length dependence coefficient of UD — 0  UDLEXP Length dependence exponent coefficient of UD — 1  UDR Coulombic scattering parameter — 0  UP1 Mobility channel length coefficent — 0  UP2 Mobility channel length coefficent — 0  UTE Mobility temperature exponent — -1.5  UTEL Length Scaling parameter for UTE — 0  VFB Flat band voltage V -0.5   | UCWLEXP   | Width-Length dependence exponent coefficient of UC | _     | 1         |
| UD1L Length Scaling parameter for UD1 — 0  UDL Length dependence coefficient of UD — 0  UDLEXP Length dependence exponent coefficient of UD — 1  UDR Coulombic scattering parameter — 0  UP1 Mobility channel length coefficent — 0  UP2 Mobility channel length coefficent — 0  UTE Mobility temperature exponent — -1.5  UTEL Length Scaling parameter for UTE — 0  VFB Flat band voltage V -0.5   | UD        | Coulombic scattering parameter                     | _     | 0.001     |
| UDL       Length dependence coefficient of UD       —       0         UDLEXP       Length dependence exponent coefficient of UD       —       1         UDR       Coulombic scattering parameter       —       0         UP1       Mobility channel length coefficent       —       0         UP2       Mobility channel length coefficent       —       0         UTE       Mobility temperature exponent       —       -1.5         UTEL       Length Scaling parameter for UTE       —       0         VFB       Flat band voltage       V       -0.5   | UD1       | Temperature coefficient for UD                     |       | 0         |
| UDLEXP     Length dependence exponent coefficient of UD     —     1       UDR     Coulombic scattering parameter     —     0       UP1     Mobility channel length coefficent     —     0       UP2     Mobility channel length coefficent     —     0       UTE     Mobility temperature exponent     —     -1.5       UTEL     Length Scaling parameter for UTE     —     0       VFB     Flat band voltage     V     -0.5   | UD1L      | Length Scaling parameter for UD1                   | _     | 0         |
| UDR     Coulombic scattering parameter     —     0       UP1     Mobility channel length coefficent     —     0       UP2     Mobility channel length coefficent     —     0       UTE     Mobility temperature exponent     —     -1.5       UTEL     Length Scaling parameter for UTE     —     0       VFB     Flat band voltage     V     -0.5   | UDL       | Length dependence coefficient of UD                | _     | 0         |
| UP1     Mobility channel length coefficent     —     0       UP2     Mobility channel length coefficent     —     0       UTE     Mobility temperature exponent     —     -1.5       UTEL     Length Scaling parameter for UTE     —     0       VFB     Flat band voltage     V     -0.5  | UDLEXP    | Length dependence exponent coefficient of UD       | _     | 1         |
| UP2     Mobility channel length coefficent     —     0       UTE     Mobility temperature exponent     —     -1.5       UTEL     Length Scaling parameter for UTE     —     0       VFB     Flat band voltage     V     -0.5   | UDR       | Coulombic scattering parameter                     |       | 0         |
| UTE     Mobility temperature exponent     —     -1.5       UTEL     Length Scaling parameter for UTE     —     0       VFB     Flat band voltage     V     -0.5  | UP1       | Mobility channel length coefficent                 | _     | 0         |
| UTEL     Length Scaling parameter for UTE     —     0       VFB     Flat band voltage     V     -0.5   | UP2       | Mobility channel length coefficent                 | _     | 0         |
| VFB Flat band voltage V -0.5   | UTE       | Mobility temperature exponent                      |       | -1.5      |
|  | UTEL      | Length Scaling parameter for UTE                   | _     | 0         |
| VFBCV Flat band voltage for CV — 0   | VFB       | Flat band voltage                                  | V     | -0.5      |
|  | VFBCV     | -  |       | 0         |

Table 2-113. BSIM6 Device Model Parameters

| Parameter   | Description  | Units | Default |
|-------------|--|-------|---------|
| VFBCVL      | Length dependence coefficient of VFBCV   | _     | 0       |
| VFBCVLEXP   | Length dependence exponent coefficient of VFBCV  | _     | 1       |
| VFBCVW      | Width dependence coefficient of VFBCV  | _     | 0       |
| VFBCVWEXP   | Width dependence exponent coefficient of VFBCV   | _     | 1       |
| VFBCVWL     | Width-Length dependence coefficient of VFBCV   | _     | 0       |
| VFBCVWLEXP  | Width-Length dependence coefficient of VFBCV   | _     | 1       |
| VFBSDOFF    |  | _     | 0       |
| VSAT        | Saturation Velocity  | _     | 100000  |
| VSATCV      | VSAT parameter for CV  | _     | 0       |
| VSATCVL     |  | _     | 0       |
| VSATCVLEXP  |  | _     | 0       |
| VSATCVW     |  | _     | 0       |
| VSATCVWEXP  |  | _     | 0       |
| VSATCVWL    |  | _     | 0       |
| VSATCVWLEXP |  | _     | 0       |
| VSATL       | Length dependence coefficient of of VSAT   | _     | 0       |
| VSATLEXP    | Length dependence exponent coefficient of VSAT   | _     | 1       |
| VSATR       | Saturation Velocity  | _     | 0       |
| VSATW       | Width dependence coefficient of of VSAT  | _     | 0       |
| VSATWEXP    | Width dependence exponent coefficient of of VSAT   | _     | 1       |
| VSATWL      | Width-Length dependence coefficient of of VSAT   | _     | 0       |
| VSATWLEXP   | Width-Length dependence exponent coefficient of of VSAT  | _     | 1       |
| VTSD        | Bottom drain junction trap-assisted current voltage dependent parameter                              |       | 0       |
| VTSS        | Bottom source junction trap-assisted current voltage dependent parameter                             | _     | 10      |
| VTSSWD      | Unit length trap-assisted current voltage dependent parameter for sidewall drain junction            | _     | 0       |
| VTSSWGD     | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall drain junction  |       | 0       |
| VTSSWGS     | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall source junction |       | 10      |
| VTSSWS      | Unit length trap-assisted current voltage dependent parameter for sidewall source junction           |       | 10      |
| WA1         |  | _     | 0       |
| WA11        |  | _     | 0       |
| WA2         |  | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WA21      |             |       | 0       |
| WAGIDL    |             | _     | 0       |
| WAGISL    |             | _     | 0       |
| WAIGBACC  |             | _     | 0       |
| WAIGBINV  |             | _     | 0       |
| WAIGC     |             | _     | 0       |
| WAIGD     |             | _     | 0       |
| WAIGS     |             | _     | 0       |
| WALPHA0   |             | _     | 0       |
| WAT       |             | _     | 0       |
| WBETA0    |             | _     | 0       |
| WBGIDL    |             | _     | 0       |
| WBGISL    |             | _     | 0       |
| WBIGBACC  |             | _     | 0       |
| WBIGBINV  |             | _     | 0       |
| WBIGC     |             | _     | 0       |
| WBIGD     |             | _     | 0       |
| WBIGS     |             | _     | 0       |
| WCDSCB    |             | _     | 0       |
| WCDSCD    |             | _     | 0       |
| WCDSCDR   |             | _     | 0       |
| WCF       |             | F     | 0       |
| WCGDL     |             | _     | 0       |
| WCGIDL    |             | _     | 0       |
| WCGISL    |             | _     | 0       |
| WCGSL     |             | _     | 0       |
| WCIGBACC  |             | _     | 0       |
| WCIGBINV  |             | _     | 0       |
| WCIGC     |             | _     | 0       |
| WCIGD     |             | _     | 0       |
| WCIGS     |             | _     | 0       |
| WCIT      |             | _     | 0       |
| WCKAPPAD  |             | _     | 0       |
| WCKAPPAS  |             | _     | 0       |
| WDELTA    |             | _     | 0       |
| WDLCIG    |             | _     | 0       |

Table 2-113. BSIM6 Device Model Parameters

| Parameter | Description                           | Units | Default |
|-----------|---------------------------------------|-------|---------|
| WDLCIGD   |                                       | _     | 0       |
| WDVTP0    |                                       | _     | 0       |
| WDVTP1    |                                       | _     | 0       |
| WDVTP2    |                                       | _     | 0       |
| WDVTP3    |                                       | _     | 0       |
| WDVTP4    |                                       | _     | 0       |
| WDVTP5    |                                       | _     | 0       |
| WEB       |                                       | _     | 0       |
| WEC       |                                       | _     | 0       |
| WEDGE     |                                       | _     | 1e-08   |
| WEGIDL    |                                       | _     | 0       |
| WEGISL    |                                       | _     | 0       |
| WEIGBINV  |                                       | _     | 0       |
| WETA0     |                                       | _     | 0       |
| WETA0R    |                                       | _     | 0       |
| WETAB     |                                       | _     | 0       |
| WEU       |                                       | _     | 0       |
| WFPROUT   |                                       | _     | 0       |
| WIGT      |                                       | _     | 0       |
| WIIT      |                                       | _     | 0       |
| WINT      | delta W for IV                        | _     | 0       |
| WK1       |                                       | _     | 0       |
| WK2       |                                       | _     | 0       |
| WK2WE     |                                       | _     | 0       |
| WKT1      |                                       | _     | 0       |
| WKT2      |                                       | _     | 0       |
| WKU0      | Width Dependence of KU0               | _     | 0       |
| WKU0WE    |                                       | _     | 0       |
| WKVTH0    | Width dependence of KVTH0             | _     | 0       |
| WKVTH0WE  |                                       | _     | 0       |
| WL        |                                       | _     | 0       |
| WLC       |                                       | _     | 0       |
| WLN       |                                       | _     | 1       |
| WLOD      | Width Parameter for Stress Effect     | _     | 0       |
| WLODKU0   | Width Parameter for u0 stress effect  | _     | 0       |
| WLODVTH   | Width Parameter for Vth stress effect | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| WMAX      | Maximum width for which this model should be used  | m     | 0       |
| WMIN      | Minimum width for which this model should be used  | m     | 0       |
| WMLT      | Width Shrinking Parameter                          | _     | 1       |
| WNDEP     |  |       | 0       |
| WNDEPCV   |  |       | 0       |
| WNFACTOR  |  | _     | 0       |
| WNGATE    |  |       | 0       |
| WNIGBACC  |  | _     | 0       |
| WNIGBINV  |  |       | 0       |
| WNSD      |  | _     | 0       |
| WNTOX     |  | _     | 0       |
| WPCLM     |  | _     | 0       |
| WPCLMCV   |  |       | 0       |
| WPCLMR    |  |       | 0       |
| WPDIBLC   |  |       | 0       |
| WPDIBLCB  |  | _     | 0       |
| WPDIBLCR  |  | _     | 0       |
| WPDITS    |  | _     | 0       |
| WPDITSD   |  | _     | 0       |
| WPEMOD    | Model flag   | _     | 0       |
| WPHIN     |  |       | 0       |
| WPOXEDGE  |  | _     | 0       |
| WPRT      |  | _     | 0       |
| WPRWB     |  |       | 0       |
| WPRWG     |  | _     | 0       |
| WPSAT     |  | _     | 0       |
| WPSATB    |  |       | 0       |
| WPSATR    |  | _     | 0       |
| WPSCBE1   |  | _     | 0       |
| WPSCBE2   |  | _     | 0       |
| WPTWG     |  | _     | 0       |
| WPTWGR    |  |       | 0       |
| WPTWGT    |  | _     | 0       |
| WPVAG     |  |       | 0       |
| WR        | W dependence parameter of S/D extension resistance | _     | 1       |
| WRDSW     |  | _     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| WRDW         —         0           WRDWMIN         —         0           WRSW         —         0           WRSWMIN         —         0           WTGIDL         —         0           WTHO         Width dependence coefficient for Rth and Cth         —         0           WUO         —         0         —         0           WUA         —         0         —         0           WUA         —         0         —         0           WUAR         —         0         —         0           WUC         —         0         —         0           WUCR         —         0         —         0           WUCS         —         0         —         0           WUCSR         —         0         —         0         —           WUD         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —         0         —        | Parameter | Description                                  | Units | Default |
|--|-----------|--|-------|---------|
| WRSW         —         0           WRSWMINN         —         0           WTGIDL         —         0           WTHO         Width dependence coefficient for Rth and Cth         —         0           WUO         —         0           WUA         —         0         0           WUC         —         0         0           WUCS         —         0         0           WUCS         —         0         0           WUCSR         —         0         0           WUD         —         0         0           WUFBE   | WRDSWMIN  |  | _     | 0       |
| WRSWMIN         —         0           WTGIDL         —         0           WTHO         Width dependence coefficient for Rth and Cth         —         0           WUO         —         0           WUOR         —         0           WUA         —         0           WUA         —         0           WUA         —         0           WUC         —         0           WUC         —         0           WUCS         —         0           WUCS         —         0           WUCSR         —         0           WUD         —         0           WUDR         —         0           WUTE         —         0           WUFBECV         —         0           WWYSATCV         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device   | WRDW      |  | _     | 0       |
| WRESWMIN         —         0           WTHO         Width dependence coefficient for Rth and Cth         —         0           WUO         —         0         0           WUOR         —         0         0           WUA1         —         0         0           WUA2         —         0         0           WUC         —         0         0           WUC1         —         0         0           WUC2         —         0         0           WUC3         —         0         0           WUC5         —         0         0           WUC5         —         0         0           WUC5         —         0         0           WUD1         —         0         0           WUD2         —         0         0           WUD4         —         0         0           WUD4         —         0         0           WUD5         —         0         0           WVFB         —         0         0           WVSAT         —         0           WWC         —         0 <td>WRDWMIN</td> <td></td> <td>_</td> <td>0</td> | WRDWMIN   |  | _     | 0       |
| WTHO         Width dependence coefficient for Rth and Cth         —         0           WUO         —         0           WUOR         —         0           WUA         —         0           WUAI         —         0           WUAR         —         0           WUC         —         0           WUCI         —         0           WUCS         —         0           WUCSR         —         0           WUCSRE         —         0           WUD         —         0           WUDR         —         0           WUDR         —         0           WUDR         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATR         —         0           WWC         —         0           WWC         —         0           WWL         —         0           WWL         —         0           WWL         —         0   | WRSW      |  | _     | 0       |
| WITHO         Width dependence coefficient for Rth and Cth         —         0           WUOR         —         0           WUOR         —         0           WUA         —         0           WUA1         —         0           WUA2         —         0           WUC         —         0           WUC1         —         0           WUC2         —         0           WUC3         —         0           WUC4         —         0           WUC5         —         0           WUC8         —         0           WUC9         —         0           WUC9         —         0           WUD         —         0           WUD         —         0           WUD         —         0           WUFB         —         0           WVFBCV         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWL         —         0           WWL         —         0  | WRSWMIN   |  | _     | 0       |
| WUOR         —         0           WUA         —         0           WUAI         —         0           WUAR         —         0           WUCR         —         0           WUCS         —         0           WUCSR         —         0           WUCSR         —         0           WUDA         —         0           WUDA         —         0           WUDA         —         0           WUDR         —         0           WUTE         —         0           WVFB         —         0           WVFBCV         —         0           WVSATCV         —         0           WVSATCV         —         0           WVSATCV         —         0           WWSATCV         —         0           WWC         —         0           WWC         —         0           WWI         — <td< td=""><td>WTGIDL</td><td></td><td>_</td><td>0</td></td<>  | WTGIDL    |  | _     | 0       |
| WUOR         —         0           WUA         —         0           WUAR         —         0           WUC         —         0           WUC1         —         0           WUC2         —         0           WUC3         —         0           WUC5         —         0           WUC5         —         0           WUC5         —         0           WUD4         —         0           WUD5         —         0           WUD6         —         0           WUD7         —         0           WUD8         —         0           WUT6         —         0           WUY5         —         0           WV9FBCV         —         0           WV9FBCV         —         0           WV9ATCV         —         0           WW         —         0           WW         —         0           WWC         —         0           WWL         —         0           WWL         —         0           WWL         —         0   | WTH0      | Width dependence coefficient for Rth and Cth | _     | 0       |
| WUA         —         0           WUAR         —         0           WUC         —         0           WUCR         —         0           WUCS         —         0           WUCSR         —         0           WUCSTE         —         0           WUD         —         0           WUDR         —         0           WUDR         —         0           WUTE         —         0           WVFB         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATR         —         0           WW         —         0           WWC         —         0           WWL         —         0 <td>WUO</td> <td></td> <td>_</td> <td>0</td>  | WUO       |  | _     | 0       |
| WUA1         —         0           WUCR         —         0           WUCS         —         0           WUCSR         —         0           WUCSTE         —         0           WUD         —         0           WUDI         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWC         —         0           WWL         —         0 <td>WU0R</td> <td></td> <td>_</td> <td>0</td>  | WU0R      |  | _     | 0       |
| WUAR         —         0           WUC         —         0           WUCR         —         0           WUCS         —         0           WUCSTE         —         0           WUD         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWC         —         0           WWL         —         0           WWL         —         0           WWL         —         0           WWL         —         0           WWIL         —         0           WWIL         —         0           WWR         —         0           WWIL         —         0           WWR         —         0           WWIL         —         0           WWIL         —         0           WWIL         —         0  | WUA       |  | _     | 0       |
| WUC         —         0           WUCR         —         0           WUCS         —         0           WUCSR         —         0           WUCSTE         —         0           WUD         —         0           WUD         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WVSATR         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWLC         —         0           WWL         —         0           WWL         —         0           WWIN         —         1           WWR         —         0           WWR         —         0           WWR         —         0           WWIL         —         0           WWR         —         0   | WUA1      |  | _     | 0       |
| WUC1         —         0           WUC8         —         0           WUCSR         —         0           WUCSTE         —         0           WUD         —         0           WUD1         —         0           WUD2         —         0           WUD4         —         0           WUD5         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWIL         —         0           WWN         —         0           WWN         —         0           WWR         —         0           WWR         —         0           WWIL         —         0           WWIL         —         0           WWR         —         0  | WUAR      |  | _     | 0       |
| WUCR         —         0           WUCSR         —         0           WUCSTE         —         0           WUD         —         0           WUD1         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWIL         —         0           WWN         —         0           WWN         —         1           WWR         —         0           WWR         —         0 <t< td=""><td>WUC</td><td></td><td>_</td><td>0</td></t<>                                     | WUC       |  | _     | 0       |
| WUCS         —         0           WUCSTE         —         0           WUD         —         0           WUD1         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WW         —         0           WW         —         0           WWC         —         0           WULDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWR         —         0           WY   | WUC1      |  | _     | 0       |
| WUCSTE         —         0           WUD         —         0           WUD1         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWN         —         0           WWN         —         0           WWN         —         0           WWN         —         0           WWR         —         0           WXJ         —         0   | WUCR      |  | _     | 0       |
| WUCSTE         —         0           WUD         —         0           WUD1         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWILC         —         0           WWN         —         0           WWN         —         0           WWN         —         0           WWR         —         0           WXJ         —         0   | WUCS      |  | _     | 0       |
| WUDD         —         0           WUDR         —         0           WUTE         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWN         —         0           WWN         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WUCSR     |  | _     | 0       |
| WUD1         —         0           WUDR         —         0           WUTE         —         0           WVFB         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWN         —         0           WWN         —         1           WWR         —         0           WXJ         —         0   | WUCSTE    |  | _     | 0       |
| WUDR         —         0           WUTE         —         0           WVFB         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATR         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWN         —         1           WWN         —         1           WWR         —         0           WXJ         —         0   | WUD       |  | _     | 0       |
| WUTE         —         0           WVFB         —         0           WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWN         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WUD1      |  | _     | 0       |
| WVFBCV         —         0           WVSAT         —         0           WVSATCV         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWLC         —         0           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0   | WUDR      |  | _     | 0       |
| WVFBCV         —         0           WVSAT         —         0           WVSATR         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0   | WUTE      |  | _     | 0       |
| WVSAT         —         0           WVSATR         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WVFB      |  | _     | 0       |
| WVSATCV         —         0           WVSATR         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WVFBCV    |  | _     | 0       |
| WVSATR         —         0           WW         —         0           WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WVSAT     |  | _     | 0       |
| WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WVSATCV   |  | _     | 0       |
| WWC         —         0           WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WVSATR    |  | _     | 0       |
| WWIDE         W of extracted Wide channel device         m         1e-05           WWL         —         0           WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0  | WW        |  | _     | 0       |
| WWLC       —       0         WWN       —       1         WWR       —       0         WXJ       —       0   | WWC       |  | _     | 0       |
| WWLC       —       0         WWN       —       1         WWR       —       0         WXJ       —       0   | WWIDE     | W of extracted Wide channel device           | m     | 1e-05   |
| WWLC         —         0           WWN         —         1           WWR         —         0           WXJ         —         0   | WWL       |  | _     |         |
| WWN — 1  WWR — 0  WXJ — 0  | WWLC      |  | _     |         |
| WWR — 0 — 0 — 0 — 0  | WWN       |  |       |         |
| WXJ — 0  | WWR       |  | _     |         |
|  | WXJ       |  |       |         |
|  |           | Variation in Ldrawn                          | m     | 0       |

**Table 2-113. BSIM6 Device Model Parameters** 

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| XGW       | Dist from gate contact center to dev edge [m]             | m     | 0       |
| XJ        | S/D junction depth  | _     | 1.5e-07 |
| XJBVD     | Fitting parameter for drain diode breakdown current       | _     | 0       |
| XJBVS     | Fitting parameter for source diode breakdown current      | _     | 1       |
| XL        | L offset for channel length due to mask/etch effect       | _     | 0       |
| XRCRG1    | 1st fitting parm the bias-dependent Rg //make it binnable | _     | 12      |
| XRCRG2    | 2nd fitting parm the bias-dependent Rg //make it binnable | _     | 1       |
| XTID      | Drain junction current temperature exponent               | _     | 0       |
| XTIS      | Source junction current temperature exponent              | _     | 3       |
| XTSD      | Power dependence of JTSD on temperature                   | _     | 0       |
| XTSS      | Power dependence of JTSS on temperature                   | _     | 0.02    |
| XTSSWD    | Power dependence of JTSSWD on temperature                 | _     | 0       |
| XTSSWGD   | Power dependence of JTSSWGD on temperature                | _     | 0       |
| XTSSWGS   | Power dependence of JTSSWGS on temperature                | _     | 0.02    |
| XTSSWS    | Power dependence of JTSSWS on temperature                 | _     | 0.02    |
| XW        | W offset for channel width due to mask/etch effect        | _     | 0       |

Table 2-114. MOSFET level 77 Output Variables

| Parameter | Description                      | Units | Default |
|-----------|----------------------------------|-------|---------|
| QBI       | Intrinsic Body Charge            | С     | none    |
| QSI       | Intrinsic Source Charge          | С     | none    |
| QDI       | Intrinsic Drain Charge           | С     | none    |
| QGI       | Intrinsic Gate Charge            | С     | none    |
| CGGI      | Intrinsic g-g MOSFET capacitance | F     | none    |
| CGBI      | Intrinsic g-b MOSFET capacitance | F     | none    |
| CGSI      | Intrinsic g-s MOSFET capacitance | F     | none    |
| CGDI      | Intrinsic g-d MOSFET capacitance | F     | none    |
| CSGI      | Intrinsic s-g MOSFET capacitance | F     | none    |
| CSBI      | Intrinsic s-b MOSFET capacitance | F     | none    |
| CSSI      | Intrinsic s-s MOSFET capacitance | F     | none    |
| CSDI      | Intrinsic s-d MOSFET capacitance | F     | none    |
| CDGI      | Intrinsic d-g MOSFET capacitance | F     | none    |
| CDBI      | Intrinsic d-b MOSFET capacitance | F     | none    |
| CDSI      | Intrinsic d-s MOSFET capacitance | F     | none    |
|           |                                  |       |         |

Table 2-114. MOSFET level 77 Output Variables

| Parameter | Description                      | Units | Default |
|-----------|----------------------------------|-------|---------|
| CDDI      | Intrinsic d-d MOSFET capacitance | F     | none    |
| CBGI      | Intrinsic b-g MOSFET capacitance | F     | none    |
| CBBI      | Intrinsic b-b MOSFET capacitance | F     | none    |
| CBSI      | Intrinsic b-s MOSFET capacitance | F     | none    |
| CBDI      | Intrinsic b-d MOSFET capacitance | F     | none    |
| QB        | Body Charge                      | С     | none    |
| QS        | Source Charge                    | С     | none    |
| QD        | Drain Charge                     | C     | none    |
| QG        | Gate Charge                      | C     | none    |
| CGG       | g-g MOSFET capacitance           | F     | none    |
| CGB       | g-b MOSFET capacitance           | F     | none    |
| CGS       | g-s MOSFET capacitance           | F     | none    |
| CGD       | g-d MOSFET capacitance           | F     | none    |
| CSG       | s-g MOSFET capacitance           | F     | none    |
| CSB       | s-b MOSFET capacitance           | F     | none    |
| CSS       | s-s MOSFET capacitance           | F     | none    |
| CSD       | s-d MOSFET capacitance           | F     | none    |
| CDG       | d-g MOSFET capacitance           | F     | none    |
| CDB       | d-b MOSFET capacitance           | F     | none    |
| CDS       | d-s MOSFET capacitance           | F     | none    |
| CDD       | d-d MOSFET capacitance           | F     | none    |
| CBG       | b-g MOSFET capacitance           | F     | none    |
| CBB       | b-b MOSFET capacitance           | F     | none    |
| CBS       | b-s MOSFET capacitance           | F     | none    |
| CBD       | b-d MOSFET capacitance           | F     | none    |
| ISUB      | Substrate Current                | A     | none    |
| IGIDL     |                                  | A     | none    |
| IGISL     |                                  | A     | none    |
| IGS       |                                  | A     | none    |
| IGD       |                                  | A     | none    |
| IGCS      |                                  | A     | none    |
| IGCD      |                                  | A     | none    |
| IGB       |                                  | A     | none    |
| CGSEXT    |                                  | F     | none    |
| CGDEXT    |                                  | F     | none    |
| CGBOV     | Front Gate Charge                | F     | none    |

Table 2-114. MOSFET level 77 Output Variables

| Parameter | Description              | Units | Default |
|-----------|--------------------------|-------|---------|
| CAPBS     |                          | F     | none    |
| CAPBD     |                          | F     | none    |
| WEFF      |                          | m     | none    |
| LEFF      |                          | m     | none    |
| WEFFCV    |                          | m     | none    |
| LEFFCV    |                          | m     | none    |
| IDS       | Drain-Source current     | A     | none    |
| IDEFF     | Effective drain Current  | A     | none    |
| ISEFF     | Effective Source Current | A     | none    |
| IGEFF     | Effective Gate Current   | A     | none    |
| IBS       |                          | A     | none    |
| IBD       |                          | A     | none    |
| VDS       | Drain to Source Voltage  | V     | none    |
| VGS       | Gate to Source Voltage   | V     | none    |
| VBS       | Body to Source Voltage   | V     | none    |
| VDSAT     |                          | V     | none    |
| GM        |                          | mho   | none    |
| GMBS      |                          | mho   | none    |
| GDS       |                          | mho   | none    |
| TK        |                          | m     | none    |
| VTH       | Threshold Voltage        | V     | none    |

## 2.3.20.11. Level 102 MOSFET Tables (PSP version 102.5)

Xyce includes a legacy version of the PSP MOSFET model, version 102.5. This version is provided because the more recent 103 versions are not backward compatible with the older 102 versions, and some foundries provide model cards that use the version 102. Development of new model cards should be done using the more recent, supported versions of PSP.

The PSP102 device supports output of the internal variables in table 2-117 on the .PRINT line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific PSP102 M device in your netlist.

Table 2-115. PSP102VA legacy MOSFET 102.5 Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| ABDRAIN   | Bottom area of drain junction   | -     | 1e-12   |
| ABSOURCE  | Bottom area of source junction  | _     | 1e-12   |
| AD        | Bottom area of drain junction   | _     | 1e-12   |
| AS        | Bottom area of source junction  | _     | 1e-12   |
| DELVTO    | Threshold voltage shift parameter                                       | _     | 0       |
| FACTUO    | Zero-field mobility pre-factor  | _     | 1       |
| L         | Design length   | _     | 1e-05   |
| LGDRAIN   | Gate-edge length of drain junction                                      | _     | 1e-06   |
| LGSOURCE  | Gate-edge length of source junction                                     | _     | 1e-06   |
| LSDRAIN   | STI-edge length of drain junction                                       | _     | 1e-06   |
| LSSOURCE  | STI-edge length of source junction                                      | _     | 1e-06   |
| М         | Alias for MULT  | _     | 1       |
| MULT      | Number of devices in parallel   | _     | 1       |
| NF        | Number of fingers   | _     | 1       |
| NGCON     | Number of gate contacts   | _     | 1       |
| PD        | Perimeter of drain junction   | _     | 1e-06   |
| PS        | Perimeter of source junction  | _     | 1e-06   |
| SA        | Distance between OD-edge and poly from one side                         | _     | 0       |
| SB        | Distance between OD-edge and poly from other side                       | _     | 0       |
| SC        | Distance between OD-edge and nearest well edge                          | _     | 0       |
| SCA       | Integral of the first distribution function for scattered well dopants  | _     | 0       |
| SCB       | Integral of the second distribution function for scattered well dopants | -     | 0       |
| SCC       | Integral of the third distribution function for scattered well dopants  | _     | 0       |
| SD        | Distance between neighbouring fingers                                   | _     | 0       |
| W         | Design width  | _     | 1e-05   |

Table 2-115. PSP102VA legacy MOSFET 102.5 Device Instance Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| XGW       | Distance from the gate contact to the channel edge | _     | 1e-07   |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| A1L       | Length dependence of A1                                     | _     | 0       |
| A10       | Geometry independent impact-ionization pre-factor           | _     | 1       |
| A1W       | Width dependence of A1                                      | _     | 0       |
| A20       | Impact-ionization exponent at TR                            | _     | 10      |
| A3L       | Length dependence of A3                                     | _     | 0       |
| A30       | Geometry independent saturation-voltage dependence of II    | _     | 1       |
| A3W       | Width dependence of A3                                      | _     | 0       |
| A4L       | Length dependence of A4                                     | _     | 0       |
| A40       | Geometry independent back-bias dependence of II             | _     | 0       |
| A4W       | Width dependence of A4                                      | _     | 0       |
| AGIDLDW   | Width dependence of GIDL pre-factor for drain side          | _     | 0       |
| AGIDLW    | Width dependence of GIDL pre-factor                         | _     | 0       |
| ALP1L1    | Length dependence of CLM enhancement factor above threshold | _     | 0       |
| ALP1L2    | Second_order length dependence of ALP1                      | _     | 0       |
| ALP1LEXP  | Exponent for length dependence of ALP1                      | _     | 0.5     |
| ALP1W     | Width dependence of ALP1                                    | _     | 0       |
| ALP2L1    | Length dependence of CLM enhancement factor below threshold | -     | 0       |
| ALP2L2    | Second_order length dependence of ALP2                      | _     | 0       |
| ALP2LEXP  | Exponent for length dependence of ALP2                      | _     | 0.5     |
| ALP2W     | Width dependence of ALP2                                    | _     | 0       |
| ALPL      | Length dependence of ALP                                    | _     | 0.0005  |
| ALPLEXP   | Exponent for length dependence of ALP                       | _     | 1       |
| ALPNOI    | Exponent for length offset for flicker noise                | _     | 2       |
| ALPW      | Width dependence of ALP                                     | _     | 0       |
| AXL       | Length dependence of AX                                     | _     | 0.4     |
| AXO       | Geometry independent linear/saturation transition factor    | _     | 18      |
| BETW1     | First higher-order width scaling coefficient of BETN        | _     | 0       |
| BETW2     | Second higher-order width scaling coefficient of BETN       | -     | 0       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| BGIDLDO   | GIDL probability factor at TR for drain side   | _     | 41      |
| BGIDLO    | GIDL probability factor at TR  | _     | 41      |
| СВВТВОТ   | Band-to-band tunneling prefactor of bottom component for source-bulk junction            | _     | 1e-12   |
| CBBTBOTD  | Band-to-band tunneling prefactor of bottom component for drain-bulk junction             | _     | 1e-12   |
| CBBTGAT   | Band-to-band tunneling prefactor of gate-edge component for source-bulk junction         | _     | 1e-18   |
| CBBTGATD  | Band-to-band tunneling prefactor of gate-edge component for drain-bulk junction          | _     | 1e-18   |
| CBBTSTI   | Band-to-band tunneling prefactor of STI-edge component for source-bulk junction          | _     | 1e-18   |
| CBBTSTID  | Band-to-band tunneling prefactor of STI-edge component for drain-bulk junction           |       | 1e-18   |
| CFBO      | Back-bias dependence of CF   |       | 0       |
| CFL       | Length dependence of DIBL-parameter  |       | 0       |
| CFLEXP    | Exponent for length dependence of CF   |       | 2       |
| CFRDW     | Outer fringe capacitance for 1 um wide channel for drain side                            |       | 0       |
| CFRW      | Outer fringe capacitance for 1 um wide channel   | _     | 0       |
| CFW       | Width dependence of CF   | _     | 0       |
| CGBOVL    | Oxide capacitance for gate-bulk overlap for 1 um long channel                            | _     | 0       |
| CGIDLDO   | Back-bias dependence of GIDL for drain side  | _     | 0       |
| CGIDLO    | Back-bias dependence of GIDL   | _     | 0       |
| CHIBO     | Tunnelling barrier height  | _     | 3.1     |
| CJORBOT   | Zero-bias capacitance per unit-of-area of bottom component for source-bulk junction      | -     | 0.001   |
| CJORBOTD  | Zero-bias capacitance per unit-of-area of bottom component for drain-bulk junction       | -     | 0.001   |
| CJORGAT   | Zero-bias capacitance per unit-of-length of gate-edge component for source-bulk junction |       | 1e-09   |
| CJORGATD  | Zero-bias capacitance per unit-of-length of gate-edge component for drain-bulk junction  | _     | 1e-09   |
| CJORSTI   | Zero-bias capacitance per unit-of-length of STI-edge component for source-bulk junction  | _     | 1e-09   |
| CJORSTID  | Zero-bias capacitance per unit-of-length of STI-edge component for drain-bulk junction   |       | 1e-09   |
| CSL       | Length dependence of CS  | _     | 0       |
| CSLEXP    | Exponent for length dependence of CS   | _     | 0       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| CSLW      | Area dependence of CS   | _     | 0       |
| CSO       | Geometry independent coulomb scattering parameter at TR                           | _     | 0       |
| CSRHBOT   | Shockley-Read-Hall prefactor of bottom component for source-bulk junction         | _     | 100     |
| CSRHBOTD  | Shockley-Read-Hall prefactor of bottom component for drain-bulk junction          | _     | 100     |
| CSRHGAT   | Shockley-Read-Hall prefactor of gate-edge component for source-bulk junction      | _     | 0.0001  |
| CSRHGATD  | Shockley-Read-Hall prefactor of gate-edge component for drain-bulk junction       | -     | 0.0001  |
| CSRHSTI   | Shockley-Read-Hall prefactor of STI-edge component for source-bulk junction       |       | 0.0001  |
| CSRHSTID  | Shockley-Read-Hall prefactor of STI-edge component for drain-bulk junction        |       | 0.0001  |
| CSW       | Width dependence of CS  | _     | 0       |
| CTATBOT   | Trap-assisted tunneling prefactor of bottom component for source-bulk junction    | _     | 100     |
| CTATBOTD  | Trap-assisted tunneling prefactor of bottom component for drain-bulk junction     | _     | 100     |
| CTATGAT   | Trap-assisted tunneling prefactor of gate-edge component for source-bulk junction | _     | 0.0001  |
| CTATGATD  | Trap-assisted tunneling prefactor of gate-edge component for drain-bulk junction  | _     | 0.0001  |
| CTATSTI   | Trap-assisted tunneling prefactor of STI-edge component for source-bulk junction  | _     | 0.0001  |
| CTATSTID  | Trap-assisted tunneling prefactor of STI-edge component for drain-bulk junction   | _     | 0.0001  |
| CTL       | Length dependence of interface states factor                                      | _     | 0       |
| CTLEXP    | Exponent for length dependence of interface states factor                         | _     | 1       |
| CTLW      | Area dependence of interface states factor  | _     | 0       |
| CTO       | Geometry-independent interface states factor                                      | _     | 0       |
| CTW       | Width dependence of interface states factor                                       |       | 0       |
| DLQ       | Effective channel length reduction for CV   | _     | 0       |
| DLSIL     | Silicide extension over the physical gate length                                  | _     | 0       |
| DNSUBO    | Effective doping bias-dependence parameter  | _     | 0       |
| DPHIBL    | Length dependence offset of PHIB  | _     | 0       |
| DPHIBLEXP | Exponent for length dependence of offset of PHIB                                  |       | 1       |
| DPHIBLW   | Area dependence of offset of PHIB   | _     | 0       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| DPHIBO    | Geometry independent offset of PHIB   | _     | 0       |
| DPHIBW    | Width dependence of offset of PHIB  | _     | 0       |
| DTA       | Temperature offset w.r.t. ambient circuit temperature   | _     | 0       |
| DWQ       | Effective channel width reduction for CV  | _     | 0       |
| EFO       | Flicker noise frequency exponent  | _     | 1       |
| EPSROXO   | Relative permittivity of gate dielectric  | _     | 3.9     |
| FBBTRBOT  | Normalization field at the reference temperature for band-to-band tunneling of bottom component for source-bulk junction    | -     | 1e+09   |
| FBBTRBOTD | Normalization field at the reference temperature for band-to-band tunneling of bottom component for drain-bulk junction     | _     | 1e+09   |
| FBBTRGAT  | Normalization field at the reference temperature for band-to-band tunneling of gate-edge component for source-bulk junction | _     | 1e+09   |
| FBBTRGATD | Normalization field at the reference temperature for band-to-band tunneling of gate-edge component for drain-bulk junction  | -     | 1e+09   |
| FBBTRSTI  | Normalization field at the reference temperature for band-to-band tunneling of STI-edge component for source-bulk junction  | _     | 1e+09   |
| FBBTRSTID | Normalization field at the reference temperature for band-to-band tunneling of STI-edge component for drain-bulk junction   | _     | 1e+09   |
| FBET1     | Relative mobility decrease due to first lateral profile   | _     | 0       |
| FBET1W    | Width dependence of relative mobility decrease due to first lateral profile   | _     | 0       |
| FBET2     | Relative mobility decrease due to second lateral profile  | _     | 0       |
| FETAO     | Effective field parameter   | -     | 1       |
| FJUNQ     | Fraction below which source-bulk junction capacitance components are considered negligible                                  | _     | 0.03    |
| FJUNQD    | Fraction below which drain-bulk junction capacitance components are considered negligible                                   | _     | 0.03    |
| FNTEXCL   | Length dependence coefficient of excess noise   | _     | 0       |
| FNTO      | Thermal noise coefficient   |       | 1       |
| FOL1      | First length dependence coefficient for short channel body effect   | _     | 0       |
| FOL2      | Second length dependence coefficient for short channel body effect  | _     | 0       |
| GC20      | Gate current slope factor   | _     | 0.375   |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter Description  | Units | Default |
|--|-------|---------|
| GC30 Gate current curvature factor   | -     | 0.063   |
| GCOO Gate tunnelling energy adjustment   | _     | 0       |
| Saturation current density at the reference temperate of bottom component for source-bulk junction           | ure _ | 1e-12   |
| IDSATRBOTD Saturation current density at the reference temperate of bottom component for drain-bulk junction | ure _ | 1e-12   |
| Saturation current density at the reference temperate of gate-edge component for source-bulk junction        | ure _ | 1e-18   |
| Saturation current density at the reference temperate of gate-edge component for drain-bulk junction         | ure _ | 1e-18   |
| Saturation current density at the reference temperate of STI-edge component for source-bulk junction         | ure _ | 1e-18   |
| Saturation current density at the reference temperate of STI-edge component for drain-bulk junction          | ure _ | 1e-18   |
| IGINVLW Gate channel current pre-factor for 1 um**2 channel area   | el _  | 0       |
| Gate overlap current pre-factor for 1 um wide chant for drain side   | nel _ | 0       |
| IGOVW Gate overlap current pre-factor for 1 um wide chan   | nel – | 0       |
| IMAX Maximum current up to which forward current behaves exponentially                                       | _     | 1000    |
| Mobility degradation/enhancement coefficient   | -     | 0       |
| KUOWEL Length dependent mobility degradation factor  | _     | 0       |
| KUOWELW Area dependent mobility degradation factor   | _     | 0       |
| KUOWEO Geometrical independent mobility degradation factor   | or –  | 0       |
| KUOWEW Width dependent mobility degradation factor   | _     | 0       |
| Saturation velocity degradation/enhancement coefficient  | _     | 0       |
| KVTHO Threshold shift parameter  | _     | 0       |
| KVTHOWEL Length dependent threshold shift parameter  |       | 0       |
| KVTHOWELW Area dependent threshold shift parameter   | -     | 0       |
| KVTHOWEO Geometrical independent threshold shift parameter   | _     | 0       |
| KVTHOWEW Width dependent threshold shift parameter   | -     | 0       |
| LAP Effective channel length reduction per side  | -     | 0       |
| LEVEL Model level  |       | 1020    |
| LINTNOI Length offset for flicker noise  | _     | 0       |
| Dength offset for meker holse  |       | 0       |
| LKUO Length dependence of KUO  | _     | O       |
| -  |       | 0       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| LLODVTH     | Length parameter for VTH-stress effect  | _     | 0       |
| LODETAO     | eta0 shift modification factor for stress effect  | _     | 1       |
| LOV         | Overlap length for gate/drain and gate/source overlap capacitance   | _     | 0       |
| LOVD        | Overlap length for gate/drain overlap capacitance   | _     | 0       |
| LP1         | Mobility-related characteristic length of first lateral profile   | -     | 1e-08   |
| LP1W        | Width dependence of mobility-related characteristic length of first lateral profile                         | _     | 0       |
| LP2         | Mobility-related characteristic length of second lateral profile  | _     | 1e-08   |
| LPCK        | Char. length of lateral doping profile  | _     | 1e-08   |
| LPCKW       | Width dependence of char. length of lateral doping profile  | _     | 0       |
| LVARL       | Length dependence of LVAR   | _     | 0       |
| LVARO       | Geom. independent difference between actual and programmed gate length                                      | _     | 0       |
| LVARW       | Width dependence of LVAR  | _     | 0       |
| MEFFTATBOT  | Effective mass (in units of m0) for trap-assisted tunneling of bottom component for source-bulk junction    | _     | 0.25    |
| MEFFTATBOTD | Effective mass (in units of m0) for trap-assisted tunneling of bottom component for drain-bulk junction     | _     | 0.25    |
| MEFFTATGAT  | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component for source-bulk junction | _     | 0.25    |
| MEFFTATGATD | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component for drain-bulk junction  | -     | 0.25    |
| MEFFTATSTI  | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component for source-bulk junction  | _     | 0.25    |
| MEFFTATSTID | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component for drain-bulk junction   | -     | 0.25    |
| MUEO        | Geometry independent mobility reduction coefficient at TR   | -     | 0.5     |
| MUEW        | Width dependence of mobility reduction coefficient at TR  | _     | 0       |
| NFALW       | First coefficient of flicker noise for 1 um**2 channel area   | _     | 8e+22   |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Third coefficient of flicker noise for 1 um**2 channel area  Third coefficient of flicker noise for 1 um**2 channel area  NOVDO Effective doping of overlap region for drain side - 5e+25  NOVO Effective doping of overlap region - 5e+25  NPCK Pocket doping level - 1e+24  NPCK Pocket doping level - 1e+24  NPCK Width dependence of pocket doping NPCK due to segregation  NPL Length dependence of gate poly-silicon doping - 0  NPD Geometry-independent gate poly-silicon doping - 1e+26  NSLPO Effective doping bias-dependence parameter - 0.05  NSUBO Geometry independent substrate doping - 3e+23  NSUBW Width dependence of background doping NSUBO Geometry independent substrate doping - 0  STANDER OF ORD Grading coefficient of bottom component for source-bulk junction - 0.5  PBOT Grading coefficient of bottom component for component for source-bulk junction - 4  PBRBOT Breakdown onset tuning parameter of bottom component for component for drain-bulk junction - 4  PBRBOT Breakdown onset tuning parameter of gate-edge component for drain-bulk junction - 4  PBRGAT Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRGAT Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 0.5  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 0.5  PGAT Grading coefficient of gate-edge component for drain-bulk junction - 0.5  PGAT Grading coefficient of gate-edge component for source-bulk junction - 0.5  PGATD Grading coefficient of gate-edge component for component for drain-bulk junction - 0.5  Zero-temperature bandgap voltage of bottom - 1.16  Zero-temperature bandgap voltage of bottom - 1.16                                      | Parameter | Description                                       | Units | Default |
|--|-----------|---|-------|---------|
| NOVDO Effective doping of overlap region for drain side — 5e+25 NOVO Effective doping of overlap region — 5e+25 NOVO Effective doping level — 1e+24 NPCKW Pocket doping level — 1e+24 NPCKW Width dependence of pocket doping NPCK due to segregation — 0 NPL Length dependence of gate poly-silicon doping — 0 NPO Geometry-independent gate poly-silicon doping — 1e+26 NSUPO Effective doping bias-dependence parameter — 0.05 NSUPO Effective doping bias-dependence parameter — 0.05 NSUPO Geometry independent substrate doping — 3e+23 NSUBW Width dependence of background doping NSUBO due to segregation — 0 PEOT Grading coefficient of bottom component for source-bulk junction — 0.5  PERBOT Grading coefficient of bottom component for drain-bulk junction — 4  PERBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction — 4  PERGAT Breakdown onset tuning parameter of gate-edge component for drain-bulk junction — 4  PERSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction — 4  PERSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction — 4  PERSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction — 4  PERSTI Grading coefficient of gate-edge component for source-bulk junction — 4  PERSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction — 4  PERSTI Grading coefficient of gate-edge component for source-bulk junction — 0.5  PERSTI Grading coefficient of gate-edge component for source-bulk junction — 0.5  PERSTI Grading coefficient of gate-edge component for source-bulk junction — 0.5  PERSTID Grading coefficient of gate-edge component for source-bulk junction — 0.5  PECAT Grading coefficient of gate-edge component for component for drain-bulk junction — 0.5   | NFBLW     |   | -     | 3e+07   |
| NOVO Effective doping of overlap region - 5e+25 NPCK Pocket doping level - 1e+24 NPCK Pocket doping level - 1e+24 NPCK Width dependence of pocket doping NPCK due to segregation - 0 NPL Length dependence of gate poly-silicon doping - 0 NPD Geometry-independent gate poly-silicon doping - 1e+26 NSLPO Effective doping bias-dependence parameter - 0.05 NSUBO Geometry independent substrate doping - 3e+23 NSUBW Width dependence of background doping NSUBO due to segregation - 0 NSUBO Grading coefficient of bottom component for source-bulk junction - 0.5 PBOTD Grading coefficient of bottom component for drain-bulk junction - 4 PBRBOTD Breakdown onset tuning parameter of bottom component for component for source-bulk junction - 4 PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction - 4 PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction - 4 PBRGATD Breakdown onset tuning parameter of gate-edge component for source-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 0.5 PGAT Grading coefficient of gate-edge component for source-bulk junction - 0.5 PGATD Grading coefficient of gate-edge component for drain-bulk junction - 0.5 PGATD Grading coefficient of gate-edge component for drain-bulk junction - 1.16 PHIGBOTD Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  | NFCLW     |   | _     | 0       |
| NPCK Pocket doping level - 1e+24  NPCKW Width dependence of pocket doping NPCK due to segregation 0  NPL Length dependence of gate poly-silicon doping - 0  NPD Geometry-independent gate poly-silicon doping - 1e+26  NSLPO Effective doping bias-dependence parameter - 0.05  NSUBO Geometry independent substrate doping - 3e+23  NSUBW Width dependence of background doping NSUBO due to segregation - 0  PBOT Grading coefficient of bottom component for source-bulk junction - 0.5  PBOTD Grading coefficient of bottom component for drain-bulk junction - 4  PBRBOTD Breakdown onset tuning parameter of bottom component for component for drain-bulk junction - 4  PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction - 4  PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction - 4  PBRGATD Breakdown onset tuning parameter of gate-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PGAT Grading coefficient of gate-edge component for source-bulk junction - 0.5  PGATD Grading coefficient of gate-edge component for drain-bulk junction - 0.5  PHIGBOT Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  PHIGBOTD Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  | NOVDO     | Effective doping of overlap region for drain side | _     | 5e+25   |
| Width dependence of pocket doping NPCK due to segregation  NPL Length dependence of gate poly-silicon doping - 0  NPO Geometry-independent gate poly-silicon doping - 1e+26  NSLPO Effective doping bias-dependence parameter - 0.05  NSUBO Geometry independent substrate doping - 3e+23  NSUBW Width dependence of background doping NSUBO due to segregation - 0  PBOT Grading coefficient of bottom component for source-bulk junction - 0.5  PBRBOT Breakdown onset tuning parameter of bottom component for component for source-bulk junction - 4  PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 0.5  PGAT Grading coefficient of gate-edge component for source-bulk junction - 0.5  PGATD Grading coefficient of gate-edge component for source-bulk junction - 0.5  PHIGBOT Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  PHIGBOT Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16   | NOVO      | Effective doping of overlap region                | _     | 5e+25   |
| Segregation  NPL Length dependence of gate poly-silicon doping  O NPO Geometry-independent gate poly-silicon doping  - 1e+26 NSLPO Effective doping bias-dependence parameter  O NSUBO Geometry independent substrate doping  Substrate doping  Width dependence of background doping NSUBO due to segregation  O  PBOT Grading coefficient of bottom component for source-bulk junction  Breakdown onset tuning parameter of bottom component for source-bulk junction  Breakdown onset tuning parameter of gate-edge component for source-bulk junction  PBRGAT Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Carding coefficient of gate-edge component for source-bulk junction  PGAT Grading coefficient of gate-edge component for source-bulk junction  Carding coefficient of gate-edge component for component for drain-bulk junction  Carding coefficient of gate-edge component for component for drain-bulk junction  Caro-temperature bandgap voltage of bottom component for drain-bulk junction  Caro-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction | NPCK      | Pocket doping level                               | _     | 1e+24   |
| NEO   Geometry-independent gate poly-silicon doping   -   1e+26  | NPCKW     |   | _     | 0       |
| NSLPO Effective doping bias-dependence parameter - 0.05 NSUBO Geometry independent substrate doping - 3e+23 NSUBW Width dependence of background doping NSUBO due to segregation - 0 PBOT Grading coefficient of bottom component for source-bulk junction - 0.5 PBOTD Grading coefficient of bottom component for drain-bulk junction - 0.5 PBRBOT Breakdown onset tuning parameter of bottom component for component for drain-bulk junction - 4 PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction - 4 PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction - 4 PBRGAT Breakdown onset tuning parameter of gate-edge component for drain-bulk junction - 4 PBRSTI Breakdown onset tuning parameter of gate-edge component for drain-bulk junction - 4 PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4 PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4 PBRSTID Crading coefficient of gate-edge component for source-bulk junction - 4 PGAT Grading coefficient of gate-edge component for source-bulk junction - 0.5 PGATD Creating-coefficient of gate-edge component for component for drain-bulk junction - 0.5 PHIGBOT Zero-temperature bandgap voltage of bottom component for source-bulk junction - 1.16 PHIGBOTD Zero-temperature bandgap voltage of gate-edge - 1.16   | NPL       | Length dependence of gate poly-silicon doping     | _     | 0       |
| NSUBO Geometry independent substrate doping - 3e+23  Width dependence of background doping NSUBO due to segregation  PBOT Grading coefficient of bottom component for source-bulk junction  PBOTD Grading coefficient of bottom component for drain-bulk junction  PBRBOTD Breakdown onset tuning parameter of bottom component for component for drain-bulk junction  PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction  PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction  PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction  PBRGATD Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PGAT Grading coefficient of gate-edge component for source-bulk junction  PGATD Grading coefficient of gate-edge component for source-bulk junction  PGATD Crading coefficient of gate-edge component for drain-bulk junction  PGATD Creo-temperature bandgap voltage of bottom component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge   | NPO       | Geometry-independent gate poly-silicon doping     | _     | 1e+26   |
| Width dependence of background doping NSUBO due to segregation  PBOT Grading coefficient of bottom component for source-bulk junction  PBOTD Grading coefficient of bottom component for drain-bulk junction  PBRBOTD Grading coefficient of bottom component for drain-bulk junction  PBRBOT Breakdown onset tuning parameter of bottom component for component for drain-bulk junction  PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction  PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction  PBRGAT Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction  PBRSTI Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PGAT Grading coefficient of gate-edge component for source-bulk junction  PGATD Grading coefficient of gate-edge component for source-bulk junction  PGATD Grading coefficient of gate-edge component for drain-bulk junction  PHIGBOT Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge   | NSLPO     | Effective doping bias-dependence parameter        | _     | 0.05    |
| due to segregation  PBOT  Grading coefficient of bottom component for source-bulk junction  PBOTD  Grading coefficient of bottom component for drain-bulk junction  Breakdown onset tuning parameter of bottom component for component for source-bulk junction  PBRBOT  Breakdown onset tuning parameter of bottom component for drain-bulk junction  PBRGAT  Breakdown onset tuning parameter of gate-edge component for source-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Capada Grading coefficient of gate-edge component for source-bulk junction  PGAT  Grading coefficient of gate-edge component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction   | NSUBO     | Geometry independent substrate doping             | _     | 3e+23   |
| PBOTD Source-bulk junction - 0.5  PBOTD Grading coefficient of bottom component for drain-bulk junction - 0.5  PBRBOT Breakdown onset tuning parameter of bottom component for source-bulk junction - 4  PBRBOTD Breakdown onset tuning parameter of bottom component for drain-bulk junction - 4  PBRGAT Breakdown onset tuning parameter of gate-edge component for source-bulk junction - 4  PBRGATD Breakdown onset tuning parameter of gate-edge component for drain-bulk junction - 4  PBRSTI Breakdown onset tuning parameter of STI-edge component for source-bulk junction - 4  PBRSTID Breakdown onset tuning parameter of STI-edge component for drain-bulk junction - 4  PGAT Grading coefficient of gate-edge component for source-bulk junction - 0.5  PGATD Grading coefficient of gate-edge component for drain-bulk junction - 0.5  PHIGBOT Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  Zero-temperature bandgap voltage of gate-edge - 1.16  | NSUBW     |   | -     | 0       |
| Breakdown onset tuning parameter of bottom component for source-bulk junction  Breakdown onset tuning parameter of bottom component for drain-bulk junction  Breakdown onset tuning parameter of bottom component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for source-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Cero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  L16   | PBOT      |   | _     | 0.5     |
| PBRBOTD component for source-bulk junction  Breakdown onset tuning parameter of bottom component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for source-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Crading coefficient of gate-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Crading coefficient of gate-edge component for drain-bulk junction  Czero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  | PBOTD     | •   | _     | 0.5     |
| Debuggat component for drain-bulk junction  Breakdown onset tuning parameter of gate-edge component for source-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  Cero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge   | PBRBOT    |   | _     | 4       |
| PBRGAT component for source-bulk junction  Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PGAT  Grading coefficient of gate-edge component for source-bulk junction  PGAT  Grading coefficient of gate-edge component for drain-bulk junction  Carding coefficient of gate-edge component for drain-bulk junction  PHIGBOT  Zero-temperature bandgap voltage of bottom component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge   | PBRBOTD   |   | _     | 4       |
| PBRSTI  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for source-bulk junction  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PGAT  Grading coefficient of gate-edge component for source-bulk junction  PGATD  Grading coefficient of gate-edge component for drain-bulk junction  PGATD  Grading coefficient of gate-edge component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  | PBRGAT    |   | _     | 4       |
| PBRSTID  Breakdown onset tuning parameter of STI-edge component for drain-bulk junction  PGAT  Grading coefficient of gate-edge component for source-bulk junction  PGATD  Grading coefficient of gate-edge component for source-bulk junction  Grading coefficient of gate-edge component for drain-bulk junction  PGATD  Grading coefficient of gate-edge component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  | PBRGATD   |   | _     | 4       |
| Component for drain-bulk junction  PGAT  Grading coefficient of gate-edge component for source-bulk junction  PGAT  Grading coefficient of gate-edge component for drain-bulk junction  PGATD  Grading coefficient of gate-edge component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge   | PBRSTI    |   |       | 4       |
| PGAT source-bulk junction - 0.5  PGATD Grading coefficient of gate-edge component for drain-bulk junction - 0.5  PHIGBOT Zero-temperature bandgap voltage of bottom component for source-bulk junction - 1.16  Zero-temperature bandgap voltage of bottom component for drain-bulk junction - 1.16  Zero-temperature bandgap voltage of gate-edge - 1.16   | PBRSTID   | •           |       | 4       |
| drain-bulk junction  Zero-temperature bandgap voltage of bottom component for source-bulk junction  PHIGBOT  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge  | PGAT      |   | _     | 0.5     |
| component for source-bulk junction  Zero-temperature bandgap voltage of bottom component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge  Zero-temperature bandgap voltage of gate-edge   | PGATD     |   | _     | 0.5     |
| component for drain-bulk junction  Zero-temperature bandgap voltage of gate-edge   | PHIGBOT   |   |       | 1.16    |
|  | PHIGBOTD  |   | _     | 1.16    |
|  | PHIGGAT   |   | _     | 1.16    |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PHIGGATD  | Zero-temperature bandgap voltage of gate-edge component for drain-bulk junction | _     | 1.16    |
| PHIGSTI   | Zero-temperature bandgap voltage of STI-edge component for source-bulk junction | _     | 1.16    |
| PHIGSTID  | Zero-temperature bandgap voltage of STI-edge component for drain-bulk junction  | -     | 1.16    |
| PKUO      | Cross-term dependence of KUO  | _     | 0       |
| PKVTHO    | Cross-term dependence of KVTHO  | -     | 0       |
| PSTI      | Grading coefficient of STI-edge component for source-bulk junction              | _     | 0.5     |
| PSTID     | Grading coefficient of STI-edge component for drain-bulk junction               | _     | 0.5     |
| QMC       | Quantum-mechanical correction factor  | _     | 1       |
| RBULKO    | Bulk resistance between node BP and BI  | _     | 0       |
| RGO       | Gate resistance   | _     | 0       |
| RINT      | Contact resistance between silicide and ploy                                    | -     | 0       |
| RJUNDO    | Drain-side bulk resistance between node BI and BD                               | _     | 0       |
| RJUNSO    | Source-side bulk resistance between node BI and BS                              | _     | 0       |
| RSB0      | Back-bias dependence of series resistance                                       | _     | 0       |
| RSGO      | Gate-bias dependence of series resistance                                       | _     | 0       |
| RSHG      | Gate electrode diffusion sheet resistance                                       | -     | 0       |
| RSW1      | Source/drain series resistance for 1 um wide channel at TR                      | _     | 2500    |
| RSW2      | Higher-order width scaling of RS  | _     | 0       |
| RVPOLY    | Vertical poly resistance  | _     | 0       |
| RWELLO    | Well resistance between node BI and B   | _     | 0       |
| SAREF     | Reference distance between OD-edge and poly from one side                       | -     | 1e-06   |
| SBREF     | Reference distance between OD-edge and poly from other side                     |       | 1e-06   |
| SCREF     | Distance between OD-edge and well edge of a reference device                    | _     | 1e-06   |
| STA20     | Temperature dependence of A2  | _     | 0       |
| STBETL    | Length dependence of temperature dependence of BETN                             |       | 0       |
| STBETLW   | Area dependence of temperature dependence of BETN                               | _     | 0       |
| STBETO    | Geometry independent temperature dependence of BETN                             | _     | 1       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| STBETW     | Width dependence of temperature dependence of BETN   | _     | 0       |
| STBGIDLDO  | Temperature dependence of BGIDL for drain side   | _     | 0       |
| STBGIDLO   | Temperature dependence of BGIDL  | _     | 0       |
| STCSO      | Temperature dependence of CS   | _     | 0       |
| STETAO     | eta0 shift factor related to VTHO change   | _     | 0       |
| STFBBTBOT  | Temperature scaling parameter for band-to-band tunneling of bottom component for source-bulk junction    | -     | -0.001  |
| STFBBTBOTD | Temperature scaling parameter for band-to-band tunneling of bottom component for drain-bulk junction     | -     | -0.001  |
| STFBBTGAT  | Temperature scaling parameter for band-to-band tunneling of gate-edge component for source-bulk junction | _     | -0.001  |
| STFBBTGATD | Temperature scaling parameter for band-to-band tunneling of gate-edge component for drain-bulk junction  | _     | -0.001  |
| STFBBTSTI  | Temperature scaling parameter for band-to-band tunneling of STI-edge component for source-bulk junction  | _     | -0.001  |
| STFBBTSTID | Temperature scaling parameter for band-to-band tunneling of STI-edge component for drain-bulk junction   | _     | -0.001  |
| STIGO      | Temperature dependence of IGINV and IGOV   | _     | 2       |
| STMUEO     | Temperature dependence of MUE  | _     | 0       |
| STRSO      | Temperature dependence of RS   | _     | 1       |
| STTHEMUO   | Temperature dependence of THEMU  | _     | 1.5     |
| STTHESATL  | Length dependence of temperature dependence of THESAT  | _     | 0       |
| STTHESATLW | Area dependence of temperature dependence of THESAT  | _     | 0       |
| STTHESATO  | Geometry independent temperature dependence of THESAT  | _     | 1       |
| STTHESATW  | Width dependence of temperature dependence of THESAT   | _     | 0       |
| STVFBL     | Length dependence of temperature dependence of VFB   | _     | 0       |
| STVFBLW    | Area dependence of temperature dependence of VFB   | _     | 0       |
| STVFBO     | Geometry-independent temperature dependence of VFB   | _     | 0.0005  |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| STVFBW     | Width dependence of temperature dependence of VFB   | _     | 0       |
| STXCORO    | Temperature dependence of XCOR  | _     | 0       |
| SWGIDL     | Flag for GIDL current, 0=turn off IGIDL   | _     | 0       |
| SWIGATE    | Flag for gate current, 0=turn off IG  | _     | 0       |
| SWIMPACT   | Flag for impact ionization current, 0=turn off II   | _     | 0       |
| SWJUNASYM  | Flag for asymmetric junctions; 0=symmetric, 1=asymmetric                                      | _     | 0       |
| SWJUNCAP   | Flag for juncap, 0=turn off juncap  | _     | 0       |
| SWJUNEXP   | Flag for JUNCAP-express; 0=full model, 1=express model  | _     | 0       |
| THEMUO     | Mobility reduction exponent at TR   | _     | 1.5     |
| THESATBO   | Back-bias dependence of velocity saturation   | _     | 0       |
| THESATGO   | Gate-bias dependence of velocity saturation   | _     | 0       |
| THESATL    | Length dependence of THESAT   | _     | 0.05    |
| THESATLEXP | Exponent for length dependence of THESAT  | _     | 1       |
| THESATLW   | Area dependence of velocity saturation parameter  | _     | 0       |
| THESATO    | Geometry independent velocity saturation parameter at TR                                      | _     | 0       |
| THESATW    | Width dependence of velocity saturation parameter   | _     | 0       |
| TKUO       | Temperature dependence of KUO   | _     | 0       |
| TOXO       | Gate oxide thickness  | _     | 2e-09   |
| TOXOVDO    | Overlap oxide thickness for drain side  | _     | 2e-09   |
| TOXOVO     | Overlap oxide thickness   | _     | 2e-09   |
| TR         | nominal (reference) temperature   | _     | 21      |
| TRJ        | reference temperature   | _     | 21      |
| TYPE       | Channel type parameter, +1=NMOS -1=PMOS   | _     | 1       |
| UO         | Zero-field mobility at TR   | _     | 0.05    |
| VBIRBOT    | Built-in voltage at the reference temperature of bottom component for source-bulk junction    | _     | 1       |
| VBIRBOTD   | Built-in voltage at the reference temperature of bottom component for drain-bulk junction     | _     | 1       |
| VBIRGAT    | Built-in voltage at the reference temperature of gate-edge component for source-bulk junction | _     | 1       |
| VBIRGATD   | Built-in voltage at the reference temperature of gate-edge component for drain-bulk junction  | _     | 1       |
| VBIRSTI    | Built-in voltage at the reference temperature of STI-edge component for source-bulk junction  | _     | 1       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| VBIRSTID  | Built-in voltage at the reference temperature of STI-edge component for drain-bulk junction | -     | 1       |
| VBRBOT    | Breakdown voltage of bottom component for source-bulk junction                              |       | 10      |
| VBRBOTD   | Breakdown voltage of bottom component for drain-bulk junction                               | -     | 10      |
| VBRGAT    | Breakdown voltage of gate-edge component for source-bulk junction                           | -     | 10      |
| VBRGATD   | Breakdown voltage of gate-edge component for drain-bulk junction                            | -     | 10      |
| VBRSTI    | Breakdown voltage of STI-edge component for source-bulk junction                            | -     | 10      |
| VBRSTID   | Breakdown voltage of STI-edge component for drain-bulk junction                             | _     | 10      |
| VFBL      | Length dependence of flat-band voltage  | _     | 0       |
| VFBLW     | Area dependence of flat-band voltage  | _     | 0       |
| VFBO      | Geometry-independent flat-band voltage at TR  | _     | -1      |
| VFBW      | Width dependence of flat-band voltage   | _     | 0       |
| VJUNREF   | Typical maximum source-bulk junction voltage; usually about 2*VSUP                          | _     | 2.5     |
| VJUNREFD  | Typical maximum drain-bulk junction voltage; usually about 2*VSUP                           | _     | 2.5     |
| VNSUBO    | Effective doping bias-dependence parameter  | _     | 0       |
| VPO       | CLM logarithmic dependence parameter  | _     | 0.05    |
| WBET      | Characteristic width for width scaling of BETN  | _     | 1e-09   |
| WEB       | Coefficient for SCB   | _     | 0       |
| WEC       | Coefficient for SCC   | _     | 0       |
| WKUO      | Width dependence of KUO   | _     | 0       |
| WKVTHO    | Width dependence of KVTHO   | _     | 0       |
| WLOD      | Width parameter   | _     | 0       |
| WLODKUO   | Width parameter for UO stress effect  | _     | 0       |
| WLODVTH   | Width parameter for VTH-stress effect   | _     | 0       |
| WOT       | Effective channel width reduction per side  | _     | 0       |
| WSEG      | Char. length of segregation of background doping NSUBO                                      | -     | 1e-08   |
| WSEGP     | Char. length of segregation of pocket doping NPCK   | _     | 1e-08   |
| WVARL     | Length dependence of WVAR   | _     | 0       |
| WVARO     | Geom. independent difference between actual and programmed field-oxide opening              | _     | 0       |

Table 2-116. PSP102VA legacy MOSFET 102.5 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| WVARW     | Width dependence of WVAR                                       | _     | 0       |
| XCORL     | Length dependence of non-universality parameter                | _     | 0       |
| XCORLW    | Area dependence of non-universality parameter                  | _     | 0       |
| XCORO     | Geometry independent non-universality parameter                | _     | 0       |
| XCORW     | Width dependence of non-universality parameter                 | _     | 0       |
| XJUNGAT   | Junction depth of gate-edge component for source-bulk junction | _     | 1e-07   |
| XJUNGATD  | Junction depth of gate-edge component for drain-bulk junction  | _     | 1e-07   |
| XJUNSTI   | Junction depth of STI-edge component for source-bulk junction  | _     | 1e-07   |
| XJUNSTID  | Junction depth of STI-edge component for drain-bulk junction   | _     | 1e-07   |

Table 2-117. MOSFET level 102 Output Variables

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| ctype     | Flag for channel type   |       | none    |
| sdint     | Flag for source-drain interchange   |       | none    |
| ise       | Total source current  | A     | none    |
| ige       | Total gate current  | A     | none    |
| ide       | Total drain current   | A     | none    |
| ibe       | Total bulk current  | A     | none    |
| ids       | Drain current, excl. avalanche, tunnel, GISL, GIDL, and junction currents | A     | none    |
| idb       | Drain to bulk current   | A     | none    |
| isb       | Source to bulk current  | A     | none    |
| igs       | Gate-source tunneling current   | A     | none    |
| igd       | Gate-drain tunneling current  | A     | none    |
| igb       | Gate-bulk tunneling current   | A     | none    |
| igcs      | Gate-channel tunneling current (source component)                         | A     | none    |
| igcd      | Gate-channel tunneling current (drain component)                          | A     | none    |
| iavl      | Substrate current due to weak avelanche                                   | A     | none    |
| igisl     | Gate-induced source leakage current                                       | A     | none    |
| igidl     | Gate-induced drain leakage current  | A     | none    |
| ijs       | Total source junction current   | A     | none    |
| ijsbot    | Source junction current (bottom component)                                | A     | none    |
| ijsgat    | Source junction current (gate-edge component)                             | A     | none    |

Table 2-117. MOSFET level 102 Output Variables

| Parameter | Description   | Units         | Default |
|-----------|---|---------------|---------|
| ijssti    | Source junction current (STI-edge component)                            | A             | none    |
| ijd       | Total drain junction current  | A             | none    |
| ijdbot    | Drain junction current (bottom component)                               | A             | none    |
| ijdgat    | Drain junction current (gate-edge component)                            | A             | none    |
| ijdsti    | Drain junction current (STI-edge component)                             | A             | none    |
| vds       | Drain-source voltage  | V             | none    |
| vgs       | Gate-source voltage   | V             | none    |
| vsb       | Source-bulk voltage   | V             | none    |
| vto       | Zero-bias threshold voltage   | V             | none    |
| vts       | Threshold voltage including back bias effects                           | V             | none    |
| vth       | Threshold voltage including back bias and drain bias effects            | V             | none    |
| vgt       | Effective gate drive voltage including back bias and drain bias effects | V             | none    |
| vdss      | Drain saturation voltage at actual bias                                 | V             | none    |
| vsat      | Saturation limit  | V             | none    |
| gm        | Transconductance  | $\Omega^{-1}$ | none    |
| gmb       | Substrate transconductance  | $\Omega^{-1}$ | none    |
| gds       | Output conductance  | $\Omega^{-1}$ | none    |
| gjs       | Source junction conductance   | $\Omega^{-1}$ | none    |
| gjd       | Drain junction conductance  | $\Omega^{-1}$ | none    |
| cdd       | Drain capacitance   | F             | none    |
| cdg       | Drain-gate capacitance  | F             | none    |
| cds       | Drain-source capacitance  | F             | none    |
| cdb       | Drain-bulk capacitance  | F             | none    |
| cgd       | Gate-drain capacitance  | F             | none    |
| cgg       | Gate capacitance  | F             | none    |
| cgs       | Gate-source capacitance   | F             | none    |
| cgb       | Gate-bulk capacitance   | F             | none    |
| csd       | Source-drain capacitance  | F             | none    |
| csg       | Source-gate capacitance   | F             | none    |
| CSS       | Source capacitance  | F             | none    |
| csb       | Source-bulk capacitance   | F             | none    |
| cbd       | Bulk-drain capacitance  | F             | none    |
| cbg       | Bulk-gate capacitance   | F             | none    |
| cbs       | Bulk-source capacitance   | F             | none    |

Table 2-117. MOSFET level 102 Output Variables

| Parameter | Description  | Units              | Default |
|-----------|--|--------------------|---------|
| cbb       | Bulk capacitance   | F                  | none    |
| cgsol     | Total gate-source overlap capacitance                            | F                  | none    |
| cgdol     | Total gate-drain overlap capacitance                             | F                  | none    |
| cjs       | Total source junction capacitance                                | F                  | none    |
| cjsbot    | Source junction capacitance (bottom component)                   | F                  | none    |
| cjsgat    | Source junction capacitance (gate-edge component)                | F                  | none    |
| cjssti    | Source junction capacitance (STI-edge component)                 | F                  | none    |
| cjd       | Total drain junction capacitance                                 | F                  | none    |
| cjdbot    | Drain junction capacitance (bottom component)                    | F                  | none    |
| cjdgat    | Drain junction capacitance (gate-edge component)                 | F                  | none    |
| cjdsti    | Drain junction capacitance (STI-edge component)                  | F                  | none    |
| weff      | Effective channel width for geometrical models                   | m                  | none    |
| leff      | Effective channel length for geometrical models                  | m                  | none    |
| ı         | Transistor gain  |                    | none    |
| rout      | Small-signal output resistance                                   | Ohm                | none    |
| vearly    | Equivalent Early voltage   | V                  | none    |
| oeff      | Gain factor  | $A/V^2$            | none    |
| fug       | Unity gain frequency at actual bias                              | Hz                 | none    |
| rg        | Gate resistance  | Ohm                | none    |
| sfl       | Flicker noise current spectral density at 1 Hz                   | A <sup>2</sup> /Hz | none    |
| sqrtsff   | Input-referred RMS white noise voltage spectral density at 1 kHz | V/sqrt(Hz)         | none    |
| sqrtsfw   | Input-referred RMS white noise voltage spectral density          | V/sqrt(Hz)         | none    |
| sid       | White noise current spectral density                             | A <sup>2</sup> /Hz | none    |
| sig       | Induced gate noise current spectral density at 1 Hz              | A <sup>2</sup> /Hz | none    |
| cigid     | Imaginary part of correlation coefficient between Sig and Sid    |                    | none    |
| fknee     | Cross-over frequency above which white noise is dominant         | Hz                 | none    |
| sigs      | Gate-source current noise spectral density                       | A <sup>2</sup> /Hz | none    |
| sigd      | Gate-drain current noise spectral density                        | A <sup>2</sup> /Hz | none    |
| siavl     | Impact ionization current noise spectral density                 | A <sup>2</sup> /Hz | none    |
| ssi       | Total source junction current noise spectral density             | A <sup>2</sup> /Hz | none    |
| sdi       | Total drain junction current noise spectral density              | A <sup>2</sup> /Hz | none    |
| lp_vfb    | Local parameter VFB after T-scaling and clipping                 | V                  | none    |
| lp_stvfb  | Local parameter STVFB after clipping                             | V/K                | none    |

Table 2-117. MOSFET level 102 Output Variables

| Local parameter TOX after clipping   m   none     Local parameter BPSROX after clipping   m   none     Local parameter BPSROX after clipping   m   none     Local parameter NEFF after clipping   V   none     Local parameter NSLP after clipping   V   none     Local parameter NSLP after clipping   V   none     Local parameter DNSUB after clipping   V   none     Local parameter DNSUB after clipping   V   none     Local parameter DPHIB after clipping   V   none     Local parameter NP after clipping   V   none     Local parameter NP after clipping   M   none     Local parameter NP after clipping   m   none     Local parameter TOXOV after clipping   m   none     Local parameter NOV after clipping   m   none     Local parameter Fafter clipping   m   none     Local parameter Fafter clipping   m   none     Local parameter Fafter clipping   m   none     Local parameter CFB after clipping   m   none     Local parameter STBET after clipping   m   none     Local parameter STBET after clipping   m   none     Local parameter STBET after clipping   none     Local parameter STMUE after T-scaling and clipping   none     Local parameter STMUE after T-scaling and clipping   none     Local parameter STMUE after T-scaling and clipping   none     Local parameter STEMUE after clipping   none     Local parameter STCA after clipping   N-1   none     Local paramete   | Parameter   | Description   | Units                 | Default |
|--|-------------|---|-----------------------|---------|
| Lp_neff         Local parameter NEFF after clipping         m <sup>-3</sup> none           Lp_vnsub         Local parameter VNSUB after clipping         V         none           Lp_ns1p         Local parameter NSLP after clipping         V         none           Lp_ns1p         Local parameter NSUB after clipping         V         none           Lp_dshib         Local parameter DNSUB after clipping         V         none           Lp_np         Local parameter PN after clipping         W         none           Lp_toxov         Local parameter TOXOV after clipping         m         none           Lp_toxov         Local parameter TOXOVD after clipping         m         none           Lp_nov         Local parameter TOXOVD after clipping         m         none           Lp_nov         Local parameter NOVD after clipping         m^3         none           Lp_cff         Local parameter TOXOVD after clipping         m^3         none           Lp_cff         Local parameter STER after clipping         mone         none           Lp_stbet         Local parameter FT after clipping         mone         none           Lp_stbet         Local parameter STBET after clipping         mone         none           Lp_stbet         Local parameter STBUE after clipping         none<   | lp_tox      | Local parameter TOX after clipping                  | m                     | none    |
| Lip_nsub Local parameter VNSUB after clipping V none Lip_nslp Local parameter NSLP after clipping V none Lip_dnsub Local parameter DNSUB after clipping V none Lip_dnsub Local parameter DNSUB after clipping V none Lip_dphib Local parameter DNSUB after clipping V none Lip_dphib Local parameter NP after clipping W none Lip_np Local parameter CT after clipping m³ none Lip_toxov Local parameter TOXOV after clipping m none Lip_toxov Local parameter TOXOV after clipping m none Lip_nov Local parameter TOXOV after clipping m³ none Lip_nov Local parameter NOV after clipping m³ none Lip_nov Local parameter NOV after clipping m³ none Lip_nov Local parameter NOV after clipping m³ none Lip_off Local parameter Fafter clipping m³ none Lip_off Local parameter Fafter clipping m³ none Lip_bfb Local parameter Fafter clipping mone Lip_stbet Local parameter STB after clipping m²/V none Lip_stbet Local parameter STBT after clipping m²/V none Lip_stbet Local parameter STBT after clipping mone Lip_stbet Local parameter STBUE after clipping mone Lip_stbet Local parameter STMUE after T-scaling and clipping m/V none Lip_stbet Local parameter STMUE after T-scaling and clipping none Lip_stbet Local parameter STMUE after T-scaling and clipping none Lip_stbemu Local parameter STTHEMU after T-scaling and clipping none Lip_stbemu Local parameter STTHEMU after T-scaling and clipping none Lip_stbemu Local parameter STTS after clipping none Lip_stbemu Local parameter STC after T-scaling and clipping none Lip_stcs Local parameter STC after T-scaling and clipping none Lip_stcs Local parameter STC after T-scaling and clipping none Lip_stcs Local parameter STC after T-scaling and clipping none Lip_stcs Local parameter STC after Clipping none Lip_stcs Local parameter STC after Clipping none Lip_stcs Local parameter STC after T-scaling and clipping None Lip_stcs Local parameter STC after clipping None None Li | lp_epsrox   | Local parameter EPSROX after clipping               |                       | none    |
| Ip_ns1p         Local parameter NSLP after clipping         V         none           Ip_dnsub         Local parameter DNSUB after clipping         V^-1         none           Ip_dphib         Local parameter DPHIB after clipping         V         none           Ip_np         Local parameter TPHIB after clipping         m^-3         none           Ip_nov         Local parameter TOXOV after clipping         m         none           Ip_toxov         Local parameter TOXOV after clipping         m         none           Ip_nov         Local parameter TOXOV after clipping         m         none           Ip_novd         Local parameter NOV after clipping         m^-3         none           Ip_novd         Local parameter NOV after clipping         m^-3         none           Ip_off         Local parameter CF after clipping         m^-3         none           Ip_off         Local parameter CF after clipping         m^-3         none           Ip_stbet         Local parameter STBET after clipping         m^-1         none           Ip_stbet         Local parameter MUE after T-scaling and clipping         m/V         none           Ip_stmue         Local parameter STMUE after clipping         none           Ip_stmue         Local parameter STMUE after clipping  | lp_neff     | Local parameter NEFF after clipping                 | $m^{-3}$              | none    |
| Local parameter DNSUB after clipping V-1 none lp_dphib Local parameter DPHIB after clipping V none lp_dphib Local parameter DPHIB after clipping V none lp_dphib Local parameter NP after clipping m-3 none lp_ct Local parameter TOXOV after clipping m none lp_ctoxov Local parameter TOXOV after clipping m none lp_toxov Local parameter TOXOV after clipping m none lp_toxov Local parameter TOXOV after clipping m none lp_nov Local parameter NOV after clipping m none lp_nov Local parameter NOV after clipping m-3 none lp_oper Local parameter NOV after clipping m-3 none lp_oper Local parameter NOV after clipping m-3 none lp_oper Local parameter TG after clipping m-3 none lp_oper Local parameter TG after clipping none lp_oper Local parameter TG after clipping NOV-1 none lp_oper Local parameter TG after clipping NOV-1 none lp_oper Local parameter BETN after T-scaling and clipping m2/(V s) none lp_oper Local parameter STBET after clipping none lp_oper Local parameter THEMU after T-scaling and clipping none lp_oper Local parameter THEMU after T-scaling and clipping none lp_oper Local parameter TTHEMU after clipping none lp_oper Local parameter TTHEMU after clipping none lp_oper Local parameter TTHEMU after clipping none lp_oper Local parameter STCS after cl | lp_vnsub    | Local parameter VNSUB after clipping                | V                     | none    |
| Local parameter DPHIB after clipping   V   none  | lp_nslp     | Local parameter NSLP after clipping                 | V                     | none    |
| Lp_np         Local parameter NP after clipping         m <sup>-3</sup> none           Lp_ct         Local parameter CT after clipping         none           Lp_toxov         Local parameter TOXOV after clipping         m         none           Lp_toxovd         Local parameter TOXOVD after clipping         m         none           Lp_nov         Local parameter NOV after clipping         m <sup>-3</sup> none           Lp_novd         Local parameter NOV after clipping         m <sup>-3</sup> none           Lp_cf         Local parameter RoVD after clipping         none         none           Lp_cfb         Local parameter STBET after clipping         none         none           Lp_stbet         Local parameter STBET after clipping         none         none           Lp_stbet         Local parameter STBET after clipping         m// none         none           Lp_stbet         Local parameter STMUE after clipping         m// none         non  | lp_dnsub    | Local parameter DNSUB after clipping                | $V^{-1}$              | none    |
| Local parameter CT after clipping mone  Local parameter TOXOV after clipping mone  Local parameter TOXOV after clipping mone  Local parameter TOXOVD after clipping mone  Local parameter NOV after clipping mone  Local parameter NOVD after clipping mone  Local parameter NOVD after clipping mone  Local parameter NOVD after clipping mone  Local parameter CF after clipping mone  Local parameter CF after clipping mone  Local parameter CF after clipping mone  Local parameter BETN after T-scaling and clipping mone  Local parameter STBET after clipping mone  Local parameter STMUE after T-scaling and clipping mone  Local parameter STMUE after clipping mone  Local parameter STMUE after Staling and clipping mone  Local parameter STMUE after Staling and clipping mone  Local parameter STMUE after Clipp | lp_dphib    | Local parameter DPHIB after clipping                | V                     | none    |
| Local parameter TOXOV after clipping m none  lp_toxovd Local parameter TOXOVD after clipping m none  lp_nov Local parameter NOV after clipping m none  lp_novd Local parameter NOV after clipping m m none  lp_cf Local parameter CF after clipping m m none  lp_cf Local parameter CF after clipping m none  lp_cfb Local parameter CFB after clipping v l none  lp_betn Local parameter BETN after T-scaling and clipping m²/(V s) none  lp_stbet Local parameter STBET after clipping m none  lp_stbet Local parameter MUE after T-scaling and clipping m/V none  lp_stmue Local parameter STMUE after clipping none  lp_stmue Local parameter STMUE after clipping none  lp_sthemu Local parameter STMUE after clipping none  lp_sthemu Local parameter STHEMU after T-scaling and clipping none  lp_stbet Local parameter STTHEMU after Clipping none  lp_stcs Local parameter STTEMU after Clipping none  lp_stcs Local parameter STCS after clipping none  lp_stcs Local parameter STCS after Clipping none  lp_stcor Local parameter STCS after clipping none  lp_stcor Local parameter STCOR after Clipping None  lp_stcor Local parameter STRS after Clip | lp_np       | Local parameter NP after clipping                   | $\mathrm{m}^{-3}$     | none    |
| Local parameter TOXOVD after clipping m none   | lp_ct       | Local parameter CT after clipping                   |                       | none    |
| 1p_nov         Local parameter NOV after clipping         m <sup>-3</sup> none           1p_novd         Local parameter NOVD after clipping         m <sup>-3</sup> none           1p_cf         Local parameter CF after clipping         v <sup>-1</sup> none           1p_cfb         Local parameter CFB after clipping         v <sup>-1</sup> none           1p_betn         Local parameter BETN after T-scaling and clipping         m <sup>2</sup> /(V s)         none           1p_stbet         Local parameter STBET after clipping         none         none           1p_stbet         Local parameter STBET after clipping         none         none           1p_stbet         Local parameter STMUE after clipping         none  | lp_toxov    | Local parameter TOXOV after clipping                | m                     | none    |
| Local parameter NOVD after clipping   m-3   none   | lp_toxovd   | Local parameter TOXOVD after clipping               | m                     | none    |
| Local parameter CF after clipping none  lp_cfb Local parameter CFB after clipping V <sup>-1</sup> none  lp_betn Local parameter BETN after T-scaling and clipping m <sup>2</sup> /(V s) none  lp_stbet Local parameter STBET after clipping none  lp_mue Local parameter MUE after T-scaling and clipping m/V none  lp_stmue Local parameter STMUE after clipping none  lp_stmue Local parameter THEMU after T-scaling and clipping none  lp_sthemu Local parameter STHEMU after clipping none  lp_sthemu Local parameter STTHEMU after clipping none  lp_st Local parameter STTHEMU after clipping none  lp_scs Local parameter STCS after clipping none  lp_stcs Local parameter STCS after clipping none  lp_stcs Local parameter STCS after clipping none  lp_stcor Local parameter XCOR after T-scaling and clipping V <sup>-1</sup> none  lp_stxcor Local parameter STXCOR after clipping none  lp_feta Local parameter FETA after clipping none  lp_rs Local parameter RS after T-scaling and clipping None  lp_rs Local parameter RS after Clipping none  lp_strs Local parameter RS after Clipping None  lp_rsb Local parameter RS after clipping None  lp_rsb Local parameter RS after clipping None  lp_rsb Local parameter RSB after clipping None  lp_thesat Local parameter RSB after clipping None  lp_thesat Local parameter THESAT after clipping None  lp_sthesat Local parameter THESAT after clipping None  lp_thesat Local parameter THESAT after clipping None   | lp_nov      | Local parameter NOV after clipping                  | $m^{-3}$              | none    |
| lp_cfb         Local parameter CFB after clipping         V <sup>-1</sup> none           lp_betn         Local parameter BETN after T-scaling and clipping         m²/(V s)         none           lp_stbet         Local parameter STBET after clipping         mone         none           lp_mue         Local parameter MUE after clipping         m/V         none           lp_stmue         Local parameter STMUE after clipping         mone         none           lp_stmue         Local parameter STMUE after clipping         none         none           lp_stmue         Local parameter THEMU after T-scaling and clipping         none         none           lp_stmue         Local parameter STHEMU after clipping         none         none           lp_stthemu         Local parameter STCS after clipping         none         none           lp_cs         Local parameter STCS after clipping         v <sup>-1</sup> none         none           lp_stcs         Local parameter STXCOR after clipping         None         none           lp_stxcor         Local parameter FETA after clipping         none         none           lp_feta         Local parameter STS after clipping         None         none           lp_stxs         Local parameter STRS after clipping         V <sup>-1</sup> none         none           lp_rss  | lp_novd     | Local parameter NOVD after clipping                 | $\mathrm{m}^{-3}$     | none    |
| Inp_betn       Local parameter BETN after T-scaling and clipping       m²/(V s)       none         Inp_stbet       Local parameter STBET after clipping       m²/(V s)       none         Inp_mue       Local parameter MUE after T-scaling and clipping       m/V       none         Inp_stmue       Local parameter STMUE after clipping       none       m/V       none         Inp_stmue       Local parameter STMUE after clipping       none       none       none         Inp_stmue       Local parameter STMUE after clipping       none       none         Inp_stmue       Local parameter STMUE after clipping       none       none         Inp_stmue       Local parameter STMUE after clipping       none       none       none         Inp_stmue       Local parameter STMUE after clipping       none       no   | lp_cf       | Local parameter CF after clipping                   |                       | none    |
| Local parameter STBET after clipping none Local parameter MUE after T-scaling and clipping m/V none Local parameter MUE after T-scaling and clipping none Local parameter STMUE after clipping none Local parameter THEMU after T-scaling and clipping none Local parameter STTHEMU after Clipping none Local parameter STTHEMU after clipping none Local parameter STCS after T-scaling and clipping none Local parameter STCS after Clipping none Local parameter STCOR after clipping None Local parameter RS after T-scaling and clipping None Local parameter STCOR after clipping None Local parameter THESAT after T-scaling and clipping None Local parameter THESAT after clipping None Local parameter STTHESAT after clipping None Local parameter STTHESAT after clipping None Local parameter STTHESAT after clipping None Local parameter THESAT after clipping None  | lp_cfb      | Local parameter CFB after clipping                  | $V^{-1}$              | none    |
| Local parameter MUE after T-scaling and clipping m/V none  Local parameter STMUE after clipping none  Local parameter STMUE after clipping none  Local parameter THEMU after T-scaling and clipping none  Local parameter STTHEMU after clipping none  Local parameter STTHEMU after clipping none  Local parameter CS after T-scaling and clipping none  Local parameter STCS after clipping none  Local parameter STCS after clipping none  Local parameter STCS after clipping none  Local parameter STCOR after clipping none  Local parameter STCOR after clipping none  Local parameter STCOR after clipping none  Local parameter FETA after clipping none  Local parameter STCOR after clipping none  Local parameter STCOR after clipping none  Local parameter STCOR after clipping none  Local parameter RS after T-scaling and clipping None  Local parameter STRS after clipping None  Local parameter RSB after clipping None  Local parameter RSG after clipping None  Local parameter THESAT after T-scaling and clipping None  Local parameter THESAT after clipping None   | lp_betn     | Local parameter BETN after T-scaling and clipping   | m <sup>2</sup> /(V s) | none    |
| lp_stmue       Local parameter STMUE after clipping       none         lp_themu       Local parameter THEMU after T-scaling and clipping       none         lp_stthemu       Local parameter STTHEMU after clipping       none         lp_cs       Local parameter CS after T-scaling and clipping       none         lp_stcs       Local parameter STCS after clipping       none         lp_stcor       Local parameter XCOR after T-scaling and clipping       V-1       none         lp_stxcor       Local parameter STXCOR after clipping       none       none         lp_feta       Local parameter FETA after clipping       none       none         lp_rs       Local parameter RS after T-scaling and clipping       Ohm       none         lp_strs       Local parameter STRS after clipping       v-1       none         lp_rsb       Local parameter RSB after clipping       V-1       none         lp_rsg       Local parameter THESAT after T-scaling and clipping       V-1       none         lp_thesat       Local parameter STTHESAT after clipping       V-1       none         lp_stthesat       Local parameter THESATB after clipping       V-1       none         lp_thesatb       Local parameter THESATG after clipping       V-1       none         lp_thesatg       Local p   | lp_stbet    | Local parameter STBET after clipping                |                       | none    |
| Local parameter THEMU after T-scaling and clipping none Lp_stthemu Local parameter STTHEMU after clipping none Lp_cs Local parameter CS after T-scaling and clipping none Lp_stcs Local parameter STCS after clipping none Lp_stcs Local parameter XCOR after Clipping none Lp_stcor Local parameter XCOR after clipping none Lp_stxcor Local parameter STXCOR after clipping none Lp_stxcor Local parameter FETA after clipping none Lp_stxcor Local parameter FETA after clipping none Lp_rs Local parameter RS after T-scaling and clipping None Lp_strs Local parameter STRS after clipping none Lp_rsb Local parameter RSB after clipping None Lp_rsb Local parameter RSG after clipping V-1 none Lp_rsg Local parameter RSG after clipping None Lp_thesat Local parameter THESAT after T-scaling and clipping None Lp_thesat Local parameter STTHESAT after clipping none Lp_thesat Local parameter THESATB after clipping None Lp_thesatb Local parameter THESATB after clipping None Lp_thesatb Local parameter THESATB after clipping None Lp_thesatg Local parameter THESATG after clipping None   | lp_mue      | Local parameter MUE after T-scaling and clipping    | m/V                   | none    |
| Local parameter STTHEMU after clipping none Local parameter CS after T-scaling and clipping none Local parameter STCS after clipping none Local parameter STCOR after T-scaling and clipping V-1 none Local parameter STXCOR after clipping none Local parameter FETA after clipping none Local parameter RS after T-scaling and clipping Ohm none Local parameter STRS after clipping none Local parameter STRS after clipping N-1 none Local parameter RSB after clipping V-1 none Local parameter RSG after clipping N-1 none Local parameter THESAT after T-scaling and clipping N-1 none Local parameter STTHESAT after clipping none Local parameter THESAT after clipping N-1 none Local parameter STTHESAT after clipping none Local parameter THESAT after clipping N-1 none  | lp_stmue    | Local parameter STMUE after clipping                |                       | none    |
| Local parameter CS after T-scaling and clipping none  Local parameter STCS after clipping none  Local parameter XCOR after T-scaling and clipping V <sup>-1</sup> none  Local parameter STXCOR after clipping none  Local parameter STXCOR after clipping none  Local parameter STXCOR after clipping none  Local parameter FETA after clipping none  Local parameter RS after T-scaling and clipping Ohm none  Local parameter STRS after clipping none  Local parameter STRS after clipping none  Local parameter RSB after clipping V <sup>-1</sup> none  Local parameter RSG after clipping V <sup>-1</sup> none  Local parameter THESAT after T-scaling and clipping V <sup>-1</sup> none  Local parameter STTHESAT after clipping V <sup>-1</sup> none  Local parameter THESAT after clipping N <sup>-1</sup> none   | lp_themu    | Local parameter THEMU after T-scaling and clipping  |                       | none    |
| Lp_stcs       Local parameter STCS after clipping       none         lp_xcor       Local parameter XCOR after T-scaling and clipping $V^{-1}$ none         lp_stxcor       Local parameter STXCOR after clipping       none         lp_feta       Local parameter FETA after clipping       none         lp_rs       Local parameter RS after T-scaling and clipping       Ohm       none         lp_strs       Local parameter STRS after clipping       none $V^{-1}$ none         lp_rsb       Local parameter RSB after clipping $V^{-1}$ none         lp_rsg       Local parameter RSG after clipping $V^{-1}$ none         lp_thesat       Local parameter THESAT after clipping $V^{-1}$ none         lp_thesatb       Local parameter THESATB after clipping $V^{-1}$ none         lp_thesatb       Local parameter THESATG after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none   | lp_stthemu  | Local parameter STTHEMU after clipping              |                       | none    |
| Local parameter XCOR after T-scaling and clipping V <sup>-1</sup> none  Local parameter STXCOR after clipping none  Local parameter FETA after clipping none  Local parameter RS after T-scaling and clipping Ohm none  Local parameter STRS after clipping none  Local parameter STRS after clipping None  Local parameter STRS after clipping none  Local parameter RSB after clipping V <sup>-1</sup> none  Local parameter RSG after clipping None  Local parameter RSG after clipping None  Local parameter THESAT after T-scaling and clipping None  Local parameter THESAT after T-scaling and clipping None  Local parameter THESAT after clipping None  | lp_cs       | Local parameter CS after T-scaling and clipping     |                       | none    |
| Local parameter STXCOR after clipping none  Local parameter FETA after clipping none  Local parameter RS after T-scaling and clipping Ohm none  Local parameter STRS after clipping none  Local parameter RSB after clipping none  Local parameter RSB after clipping V-1 none  Local parameter RSG after clipping V-1 none  Local parameter THESAT after T-scaling and clipping V-1 none  Local parameter THESAT after T-scaling and clipping V-1 none  Local parameter THESAT after Clipping none  Local parameter THESAT after clipping none  Local parameter THESATB after clipping none  Local parameter THESATB after clipping N-1 none  Local parameter THESATB after clipping none  Local parameter THESATB after clipping N-1 none   | lp_stcs     | Local parameter STCS after clipping                 |                       | none    |
| Local parameter FETA after clipping none  Local parameter RS after T-scaling and clipping Ohm none  Local parameter STRS after clipping none  Local parameter RSB after clipping V-1 none  Local parameter RSG after clipping V-1 none  Local parameter THESAT after T-scaling and clipping V-1 none  Local parameter THESAT after T-scaling and clipping V-1 none  Local parameter STTHESAT after clipping none  Local parameter THESAT after clipping none  Local parameter THESATB after clipping V-1 none  Local parameter THESATB after clipping none  Local parameter THESATB after clipping N-1 none  Local parameter THESATG after clipping N-1 none  | lp_xcor     | Local parameter XCOR after T-scaling and clipping   | $V^{-1}$              | none    |
| lp_rsLocal parameter RS after T-scaling and clippingOhmnonelp_strsLocal parameter STRS after clippingnonelp_rsbLocal parameter RSB after clipping $V^{-1}$ nonelp_rsgLocal parameter RSG after clipping $V^{-1}$ nonelp_thesatLocal parameter THESAT after T-scaling and clipping $V^{-1}$ nonelp_stthesatLocal parameter STTHESAT after clippingnonelp_thesatbLocal parameter THESATB after clipping $V^{-1}$ nonelp_thesatgLocal parameter THESATG after clipping $V^{-1}$ nonelp_axLocal parameter AX after clipping $V^{-1}$ none  | lp_stxcor   | Local parameter STXCOR after clipping               |                       | none    |
| lp_strs       Local parameter STRS after clipping       none         lp_rsb       Local parameter RSB after clipping $V^{-1}$ none         lp_rsg       Local parameter RSG after clipping $V^{-1}$ none         lp_thesat       Local parameter THESAT after T-scaling and clipping $V^{-1}$ none         lp_stthesat       Local parameter STTHESAT after clipping       none         lp_thesatb       Local parameter THESATB after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_ax       Local parameter AX after clipping       none   | lp_feta     | Local parameter FETA after clipping                 |                       | none    |
| lp_rsb       Local parameter RSB after clipping $V^{-1}$ none         lp_rsg       Local parameter RSG after clipping $V^{-1}$ none         lp_thesat       Local parameter THESAT after T-scaling and clipping $V^{-1}$ none         lp_stthesat       Local parameter STTHESAT after clipping       none         lp_thesatb       Local parameter THESATB after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_ax       Local parameter AX after clipping       none  | lp_rs       | Local parameter RS after T-scaling and clipping     | Ohm                   | none    |
| lp_rsg       Local parameter RSG after clipping $V^{-1}$ none         lp_thesat       Local parameter THESAT after T-scaling and clipping $V^{-1}$ none         lp_stthesat       Local parameter STTHESAT after clipping       none         lp_thesatb       Local parameter THESATB after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_ax       Local parameter AX after clipping       none  | lp_strs     | Local parameter STRS after clipping                 |                       | none    |
| lp_thesat       Local parameter THESAT after T-scaling and clipping $V^{-1}$ none         lp_stthesat       Local parameter STTHESAT after clipping       none         lp_thesatb       Local parameter THESATB after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_ax       Local parameter AX after clipping       none  | lp_rsb      | Local parameter RSB after clipping                  | $V^{-1}$              | none    |
| lp_stthesat       Local parameter STTHESAT after clipping       none         lp_thesatb       Local parameter THESATB after clipping $V^{-1}$ none         lp_thesatg       Local parameter THESATG after clipping $V^{-1}$ none         lp_ax       Local parameter AX after clipping       none  | lp_rsg      | Local parameter RSG after clipping                  | $V^{-1}$              | none    |
| lp_thesatb         Local parameter THESATB after clipping $V^{-1}$ none           lp_thesatg         Local parameter THESATG after clipping $V^{-1}$ none           lp_ax         Local parameter AX after clipping         none   | lp_thesat   | Local parameter THESAT after T-scaling and clipping | $V^{-1}$              | none    |
| lp_thesatg       Local parameter THESATG after clipping       V <sup>-1</sup> none         lp_ax       Local parameter AX after clipping       none  | lp_stthesat | Local parameter STTHESAT after clipping             |                       | none    |
| lp_ax Local parameter AX after clipping none   | lp_thesatb  | Local parameter THESATB after clipping              | $V^{-1}$              | none    |
| - · · · · · · · · · · · · · · · · · · ·  | lp_thesatg  | Local parameter THESATG after clipping              | $V^{-1}$              | none    |
| lp_alp Local parameter ALP after clipping none   | lp_ax       | Local parameter AX after clipping                   |                       | none    |
|  |             | Local parameter ALP after clipping                  |                       | none    |

Table 2-117. MOSFET level 102 Output Variables

| Parameter   | Description   | Units                 | Default |
|-------------|---|-----------------------|---------|
| lp_alp1     | Local parameter ALP1 after clipping                 | V                     | none    |
| lp_alp2     | Local parameter ALP2 after clipping                 | $V^{-1}$              | none    |
| lp_vp       | Local parameter VP after clipping                   | V                     | none    |
| lp_a1       | Local parameter A1 after clipping                   |                       | none    |
| lp_a2       | Local parameter A2 after T-scaling and clipping     | V                     | none    |
| lp_sta2     | Local parameter STA2 after clipping                 |                       | none    |
| lp_a3       | Local parameter A3 after clipping                   |                       | none    |
| lp_a4       | Local parameter A4 after clipping                   | 1/sqrt(V)             | none    |
| lp_gco      | Local parameter GCO after clipping                  |                       | none    |
| lp_iginv    | Local parameter IGINV after T-scaling and clipping  | A                     | none    |
| lp_igov     | Local parameter IGOV after T-scaling and clipping   | A                     | none    |
| lp_igovd    | Local parameter IGOVD after T-scaling and clipping  | A                     | none    |
| lp_stig     | Local parameter STIG after clipping                 |                       | none    |
| lp_gc2      | Local parameter GC2 after clipping                  |                       | none    |
| lp_gc3      | Local parameter GC3 after clipping                  |                       | none    |
| lp_chib     | Local parameter CHIB after clipping                 | V                     | none    |
| lp_agidl    | Local parameter AGIDL after clipping                | A/V <sup>3</sup>      | none    |
| lp_agidld   | Local parameter AGIDLD after clipping               | $A/V^3$               | none    |
| lp_bgidl    | Local parameter BGIDL after T-scaling and clipping  | V                     | none    |
| lp_bgidld   | Local parameter BGIDLD after T-scaling and clipping | V                     | none    |
| lp_stbgidl  | Local parameter STBGIDL after clipping              | V/K                   | none    |
| lp_stbgidld | Local parameter STBGIDLD after clipping             | V/K                   | none    |
| lp_cgidl    | Local parameter CGIDL after clipping                |                       | none    |
| lp_cgidld   | Local parameter CGIDLD after clipping               |                       | none    |
| lp_cox      | Local parameter COX after clipping                  | F                     | none    |
| lp_cgov     | Local parameter CGOV after clipping                 | F                     | none    |
| lp_cgovd    | Local parameter CGOVD after clipping                | F                     | none    |
| lp_cgbov    | Local parameter CGBOV after clipping                | F                     | none    |
| lp_cfr      | Local parameter CFR after clipping                  | F                     | none    |
| lp_cfrd     | Local parameter CFRD after clipping                 | F                     | none    |
| lp_fnt      | Local parameter FNT after clipping                  |                       | none    |
| lp_fntexc   | Local parameter FNTEXC after clipping               |                       | none    |
| lp_nfa      | Local parameter NFA after clipping                  | 1/(V m <sup>4</sup> ) | none    |
| lp_nfb      | Local parameter NFB after clipping                  | 1/(V m <sup>2</sup> ) | none    |
| lp_nfc      | Local parameter NFC after clipping                  | $V^{-1}$              | none    |
| lp_ef       | Local parameter EF after clipping                   |                       | none    |

Table 2-117. MOSFET level 102 Output Variables

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| lp_rg      | Local parameter RG after clipping  | Ohm   | none    |
| lp_rbulk   | Local parameter RBULK after clipping   | Ohm   | none    |
| lp_rwell   | Local parameter RWELL after clipping   | Ohm   | none    |
| lp_rjuns   | Local parameter RJUNS after clipping   | Ohm   | none    |
| lp_rjund   | Local parameter RJUND after clipping   | Ohm   | none    |
| z k        | Device Temperature   | K     | none    |
| cjosbot    | Bottom component of total zero-bias source junction capacitance at device temperature    | F     | none    |
| cjossti    | STI-edge component of total zero-bias source junction capacitance at device temperature  | F     | none    |
| cjosgat    | Gate-edge component of total zero-bias source junction capacitance at device temperature | F     | none    |
| vbisbot    | Built-in voltage of source-side bottom junction at device temperature                    | V     | none    |
| vbissti    | Built-in voltage of source-side STI-edge junction at device temperature                  | V     | none    |
| vbisgat    | Built-in voltage of source-side gate-edge junction at device temperature                 | V     | none    |
| idsatsbot  | Total source-side bottom junction saturation current                                     | A     | none    |
| idsatssti  | Total source-side STI-edge junction saturation current                                   | A     | none    |
| idsatsgat  | Total source-side gate-edge junction saturation current                                  | A     | none    |
| cjosbotd   | Bottom component of total zero-bias drain junction capacitance at device temperature     | F     | none    |
| cjosstid   | STI-edge component of total zero-bias drain junction capacitance at device temperature   | F     | none    |
| cjosgatd   | Gate-edge component of total zero-bias drain junction capacitance at device temperature  | F     | none    |
| vbisbotd   | Built-in voltage of drain-side bottom junction at device temperature                     | V     | none    |
| vbisstid   | Built-in voltage of drain-side STI-edge junction at device temperature                   | V     | none    |
| vbisgatd   | Built-in voltage of drain-side gate-edge junction at device temperature                  | V     | none    |
| idsatsbotd | Total drain-side bottom junction saturation current                                      | A     | none    |
| ldsatsstid | Total drain-side STI-edge junction saturation current                                    | A     | none    |
| idsatsgatd | Total drain-side gate-edge junction saturation current                                   | A     | none    |

## 2.3.20.12. Level 103 and 1031 MOSFET Tables (PSP version 103.4)

Xyce includes the PSP MOSFET model, version 103.4 [30]. The version without self-heating is the level 103 MOSFET, and the version with self-heating is the level 1031. Note that the level 1031 MOSFET requires five nodes on its instance line: drain, gate, source, bulk, and dt. The fifth node will be the temperature rise of the device due to self-heating.

Full documentation for the PSP model is available on its web site,

http://www.cea.fr/cea-tech/leti/pspsupport. Instance and model parameters for the PSP model are given in tables 2-118, 2-119, 2-121, and 2-122.

The PSP103 devices support output of the internal variables in table 2-120 and table 2-123 on the <code>.PRINT</code> line of a netlist. To access them from a print line, use the syntax N (<instance>:<variable>) where "<instance>" refers to the name of the specific PSP103 M device in your netlist.

Table 2-118. PSP103VA MOSFET Device Instance Parameters

| Parameter  | Description  | Units          | Default |
|------------|--|----------------|---------|
| ABDRAIN    | Bottom area of drain junction                        | $m^2$          | 1e-12   |
| ABSOURCE   | Bottom area of source junction                       | m <sup>2</sup> | 1e-12   |
| AD         | Bottom area of drain junction                        | m <sup>2</sup> | 1e-12   |
| AS         | Bottom area of source junction                       | $m^2$          | 1e-12   |
| DELVTO     | Threshold voltage shift parameter                    | V              | 0       |
| DELVTOEDGE | Threshold voltage shift parameter of edge transistor | V              | 0       |
| FACTUO     | Zero-field mobility pre-factor                       | _              | 1       |
| FACTUOEDGE | Zero-field mobility pre-factor of edge transistor    | _              | 1       |
| JW         | Gate-edge length of source/drain junction            | m              | 1e-06   |
| L          | Design length  | m              | 1e-05   |
| LGDRAIN    | Gate-edge length of drain junction                   | m              | 1e-06   |
| LGSOURCE   | Gate-edge length of source junction                  | m              | 1e-06   |
| LSDRAIN    | STI-edge length of drain junction                    | m              | 1e-06   |
| LSSOURCE   | STI-edge length of source junction                   | m              | 1e-06   |
| М          | Alias for MULT                                       | _              | 1       |
| MULT       | Number of devices in parallel                        | _              | 1       |
| NF         | Number of fingers                                    | _              | 1       |
| NGCON      | Number of gate contacts                              | _              | 1       |
| NRD        | Number of squares of drain diffusion                 | _              | 0       |
| NRS        | Number of squares of source diffusion                | _              | 0       |
| PD         | Perimeter of drain junction                          | m              | 1e-06   |
| PS         | Perimeter of source junction                         | m              | 1e-06   |
| SA         | Distance between OD-edge and poly from one side      | m              | 0       |
| SB         | Distance between OD-edge and poly from other side    | m              | 0       |
| SC         | Distance between OD-edge and nearest well edge       | m              | 0       |

Table 2-118. PSP103VA MOSFET Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| SCA       | Integral of the first distribution function for scattered well dopants  | _     | 0       |
| SCB       | Integral of the second distribution function for scattered well dopants | _     | 0       |
| scc       | Integral of the third distribution function for scattered well dopants  | _     | 0       |
| SD        | Distance between neighbouring fingers                                   | m     | 0       |
| W         | Design width  | m     | 1e-05   |
| XGW       | Distance from the gate contact to the channel edge                      | m     | 1e-07   |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter | Description   | Units            | Default |
|-----------|---|------------------|---------|
| A1        | Impact-ionization pre-factor                                | _                | 1       |
| A1L       | Length dependence of A1                                     | _                | 0       |
| A10       | Geometry independent impact-ionization pre-factor           | _                | 1       |
| A1W       | Width dependence of A1                                      | _                | 0       |
| A2        | Impact-ionization exponent at TR                            | V                | 10      |
| A20       | Impact-ionization exponent at TR                            | V                | 10      |
| A3        | Saturation-voltage dependence of impact-ionization          | _                | 1       |
| A3L       | Length dependence of A3                                     | _                | 0       |
| A30       | Geometry independent saturation-voltage dependence of II    | _                | 1       |
| A3W       | Width dependence of A3                                      | _                | 0       |
| A4        | Back-bias dependence of impact-ionization                   | $V^{-1/2}$       | 0       |
| A4L       | Length dependence of A4                                     | _                | 0       |
| A40       | Geometry independent back-bias dependence of II             | $V^{-1/2}$       | 0       |
| A4W       | Width dependence of A4                                      | _                | 0       |
| AGIDL     | GIDL pre-factor   | A/V <sup>3</sup> | 0       |
| AGIDLD    | GIDL pre-factor for drain side                              | A/V <sup>3</sup> | 0       |
| AGIDLDW   | Width dependence of GIDL pre-factor for drain side          | A/V <sup>3</sup> | 0       |
| AGIDLW    | Width dependence of GIDL pre-factor                         | A/V <sup>3</sup> | 0       |
| ALP       | CLM pre-factor  | _                | 0.01    |
| ALP1      | CLM enhancement factor above threshold                      | V                | 0       |
| ALP1L1    | Length dependence of CLM enhancement factor above threshold | V                | 0       |
| ALP1L2    | Second_order length dependence of ALP1                      | _                | 0       |
| ALP1LEXP  | Exponent for length dependence of ALP1                      | _                | 0.5     |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter | Description  | Units                | Default |
|-----------|--|----------------------|---------|
| ALP1W     | Width dependence of ALP1   | _                    | 0       |
| ALP2      | CLM enhancement factor below threshold   | $V^{-1}$             | 0       |
| ALP2L1    | Length dependence of CLM enhancement factor below threshold                      | $V^{-1}$             | 0       |
| ALP2L2    | Second_order length dependence of ALP2   | _                    | 0       |
| ALP2LEXP  | Exponent for length dependence of ALP2   |                      | 0.5     |
| ALP2W     | Width dependence of ALP2   | _                    | 0       |
| ALPL      | Length dependence of ALP   | _                    | 0.0005  |
| ALPLEXP   | Exponent for length dependence of ALP  | _                    | 1       |
| ALPNOI    | Exponent for length offset for flicker noise                                     | _                    | 2       |
| ALPW      | Width dependence of ALP  | _                    | 0       |
| ΑX        | Linear/saturation transition factor  | _                    | 3       |
| AXL       | Length dependence of AX  | _                    | 0.4     |
| YXO       | Geometry independent linear/saturation transition factor                         | _                    | 18      |
| BETEDGEW  | Width scaling coefficient of edge transistor mobility                            | _                    | 0       |
| BETN      | Channel aspect ratio times zero-field mobility                                   | m <sup>2</sup> /(Vs) | 0.07    |
| BETNEDGE  | Channel aspect ratio times zero-field mobility of edge transistor                | m <sup>2</sup> /(Vs) | 0.0005  |
| BETW1     | First higher-order width scaling coefficient of BETN                             | _                    | 0       |
| BETW2     | Second higher-order width scaling coefficient of BETN                            | _                    | 0       |
| BGIDL     | GIDL probability factor at TR  | V                    | 41      |
| BGIDLD    | GIDL probability factor at TR for drain side                                     | V                    | 41      |
| GIDLDO    | GIDL probability factor at TR for drain side                                     | V                    | 41      |
| BGIDLO    | GIDL probability factor at TR  | V                    | 41      |
| СВВТВОТ   | Band-to-band tunneling prefactor of bottom component for source-bulk junction    | A/V <sup>3</sup>     | 1e-12   |
| CBBTBOTD  | Band-to-band tunneling prefactor of bottom component for drain-bulk junction     | A/V <sup>3</sup>     | 1e-12   |
| CBBTGAT   | Band-to-band tunneling prefactor of gate-edge component for source-bulk junction | Am/V <sup>3</sup>    | 1e-18   |
| CBBTGATD  | Band-to-band tunneling prefactor of gate-edge component for drain-bulk junction  | Am/V <sup>3</sup>    | 1e-18   |
| CBBTSTI   | Band-to-band tunneling prefactor of STI-edge component for source-bulk junction  | Am/V <sup>3</sup>    | 1e-18   |
| CBBTSTID  | Band-to-band tunneling prefactor of STI-edge component for drain-bulk junction   | Am/V <sup>3</sup>    | 1e-18   |
| CF        | DIBL-parameter   | _                    | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter  | Description  | Units    | Default |
|------------|--|----------|---------|
| CFB        | Back bias dependence of CF   | $V^{-1}$ | 0       |
| CFBEDGE    | Bulk voltage dependence parameter of DIBL-parameter of edge transistors  | $V^{-1}$ | 0       |
| CFBEDGEO   | Bulk voltage dependence parameter of DIBL-parameter of edge transistors  | $V^{-1}$ | 0       |
| CFBO       | Back-bias dependence of CF   | $V^{-1}$ | 0       |
| CFD        | Drain voltage dependence of CF   | $V^{-1}$ | 0       |
| CFDEDGE    | Drain voltage dependence parameter of DIBL-parameter of edge transistors | $V^{-1}$ | 0       |
| CFDEDGEO   | Drain voltage dependence parameter of DIBL-parameter of edge transistors | $V^{-1}$ | 0       |
| CFDO       | Drain voltage dependence of CF   | $V^{-1}$ | 0       |
| CFEDGE     | DIBL parameter of edge transistors                                       | _        | 0       |
| CFEDGEL    | Length dependence of DIBL-parameter of edge transistors                  | _        | 0       |
| CFEDGELEXP | Exponent for length dependence of DIBL-parameter of edge transistors     |          | 2       |
| CFEDGEW    | Width dependence of DIBL-parameter of edge transistors                   | _        | 0       |
| CFL        | Length dependence of DIBL-parameter                                      | _        | 0       |
| CFLEXP     | Exponent for length dependence of CF                                     | _        | 2       |
| CFR        | Outer fringe capacitance   | F        | 0       |
| CFRD       | Outer fringe capacitance for drain side                                  | F        | 0       |
| CFRDW      | Outer fringe capacitance for 1 um wide channel for drain side            | F        | 0       |
| CFRW       | Outer fringe capacitance for 1 um wide channel                           | F        | 0       |
| CFW        | Width dependence of CF   | _        | 0       |
| CGBOV      | Oxide capacitance for gate-bulk overlap                                  | F        | 0       |
| CGBOVL     | Oxide capacitance for gate-bulk overlap for 1 um long channel            | F        | 0       |
| CGIDL      | Back-bias dependence of GIDL   | _        | 0       |
| CGIDLD     | Back-bias dependence of GIDL for drain side                              |          | 0       |
| CGIDLDO    | Back-bias dependence of GIDL for drain side                              |          | 0       |
| CGIDLO     | Back-bias dependence of GIDL   | _        | 0       |
| CGOV       | Oxide capacitance for gate-drain/source overlap                          | F        | 1e-15   |
| CGOVD      | Oxide capacitance for gate-drain overlap                                 | F        | 1e-15   |
| CHIB       | Tunnelling barrier height  | V        | 3.1     |
| CHIBO      | Tunnelling barrier height  | V        | 3.1     |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter | Description  | Units            | Default |
|-----------|--|------------------|---------|
| CJORBOT   | Zero-bias capacitance per unit-of-area of bottom component for source-bulk junction      | F/m <sup>2</sup> | 0.001   |
| CJORBOTD  | Zero-bias capacitance per unit-of-area of bottom component for drain-bulk junction       | F/m <sup>2</sup> | 0.001   |
| CJORGAT   | Zero-bias capacitance per unit-of-length of gate-edge component for source-bulk junction | F/m              | 1e-09   |
| CJORGATD  | Zero-bias capacitance per unit-of-length of gate-edge component for drain-bulk junction  | F/m              | 1e-09   |
| CJORSTI   | Zero-bias capacitance per unit-of-length of STI-edge component for source-bulk junction  | F/m              | 1e-09   |
| CJORSTID  | Zero-bias capacitance per unit-of-length of STI-edge component for drain-bulk junction   | F/m              | 1e-09   |
| COX       | Oxide capacitance for intrinsic channel  | F                | 1e-14   |
| CS        | Coulomb scattering parameter at TR   | _                | 0       |
| CSL       | Length dependence of CS  | _                | 0       |
| CSLEXP    | Exponent for length dependence of CS   | _                | 1       |
| CSLW      | Area dependence of CS  | _                | 0       |
| CSO       | Geometry independent coulomb scattering parameter at TR                                  | _                | 0       |
| CSRHBOT   | Shockley-Read-Hall prefactor of bottom component for source-bulk junction                | A/m <sup>3</sup> | 100     |
| CSRHBOTD  | Shockley-Read-Hall prefactor of bottom component for drain-bulk junction                 | A/m <sup>3</sup> | 100     |
| CSRHGAT   | Shockley-Read-Hall prefactor of gate-edge component for source-bulk junction             | A/m <sup>2</sup> | 0.0001  |
| CSRHGATD  | Shockley-Read-Hall prefactor of gate-edge component for drain-bulk junction              | A/m <sup>2</sup> | 0.0001  |
| CSRHSTI   | Shockley-Read-Hall prefactor of STI-edge component for source-bulk junction              | A/m <sup>2</sup> | 0.0001  |
| CSRHSTID  | Shockley-Read-Hall prefactor of STI-edge component for drain-bulk junction               | A/m <sup>2</sup> | 0.0001  |
| CSW       | Width dependence of CS   | _                | 0       |
| CT        | Interface states factor  |                  | 0       |
| СТАТВОТ   | Trap-assisted tunneling prefactor of bottom component for source-bulk junction           | A/m <sup>3</sup> | 100     |
| CTATBOTD  | Trap-assisted tunneling prefactor of bottom component for drain-bulk junction            | A/m <sup>3</sup> | 100     |
| CTATGAT   | Trap-assisted tunneling prefactor of gate-edge component for source-bulk junction        | A/m <sup>2</sup> | 0.0001  |
| CTATGATD  | Trap-assisted tunneling prefactor of gate-edge component for drain-bulk junction         | A/m <sup>2</sup> | 0.0001  |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| CTATISTI         Trap-assisted tunneling prefactor of STI-edge component for source-bulk junction         A/m²         0,0001           CTATISTID         Trap-assisted tunneling prefactor of STI-edge component for drain-bulk junction         A/m²         0,0001           CTEDGE         Interface states factor of edge transistors         —         0           CTEDGEL         Length dependence of interface states factor of edge transistors         —         0           CTEDGELEXP         Exponent for length dependence of interface states factor of edge transistors         —         0           CTEDGEO         Geometry-independent interface states factor         —         0           CTL         Length dependence of interface states factor         —         0           CTL         Length dependence of interface states factor         —         0           CTL         Area dependence of interface states factor         —         0           CTL         Area dependence of interface states factor         —         0           CTL         Area dependence of interface states factor         —         0           CTL         Area dependence of interface states factor         —         0           CTL         Area dependence of DELVTAC         V         0           CTL         Exponent for length dependence of offset  | Parameter     | Description   | Units            | Default |
|--|---------------|---|------------------|---------|
| CTEDGE Interface states factor of edge transistors — 0  CTEDGEL Length dependence of interface states factor of edge transistors  CTEDGELEXP Exponent for length dependence of interface states factor of edge transistors  CTEDGELEXP Exponent for length dependence of interface states factor of edge transistors  CTEDGEO Geometry-independent interface states factor of edge transistors  CTI. Length dependence of interface states factor — 0  CTI. Length dependence of interface states factor — 0  CTI. Exponent for length dependence of interface states factor — 0  CTI. Area dependence of interface states factor — 0  CTO Geometry-independent interface states factor — 0  CTW Width dependence of interface states factor — 0  CTW Width dependence of interface states factor — 0  DELVTAC Offset parameter for PHIB in separate charge calculation  DELVTAC Length dependence of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in very a calculation very dependence of DELVTAC V 0  DELVTACW Width dependence of DELVTAC V 0  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUB Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB offset V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGEL Sexponent for length dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Width dependence of edge transistor PHIB offset V 0  | CTATSTI       |   | A/m <sup>2</sup> | 0.0001  |
| CTEDGEL         Length dependence of interface states factor of edge transistors         — 0           CTEDGELEXP         Exponent for length dependence of interface states factor of edge transistors         — 1           CTEDGEO         Geometry-independent interface states factor of edge transistors         — 0           CTL         Length dependence of interface states factor         — 0           CTLEXP         Exponent for length dependence of interface states factor         — 0           CTD         Geometry-independent interface states factor         — 0           CTO         Geometry-independent interface states factor         — 0           CTW         Width dependence of interface states factor         — 0           CTW         Width dependence of interface states factor         — 0           CTW         Width dependence of interface states factor         — 0           CTW         Width dependence of DELVTAC         V         0           DELVTAC         Coffest parameter for PHIB in separate charge calculation         V         0           DELVTACL         Length dependence of DELVTAC         V         0           DELVTACUM         Area dependence of DELVTAC         V         0           DELVTACO         Geom. independent offset parameter for PHIB in separate charge calculation         V         0  | CTATSTID      |   | A/m <sup>2</sup> | 0.0001  |
| EXPONENT FOR EXPONENT FOR INTERPRETABLE AND PRIBEDGEL EXP  EXPONENT FOR Independence of interface states factor of edge transistors  CTEDGELEXP  EXPONENT FOR Independent interface states factor of edge transistors  CTL  Length dependence of interface states factor — 0  CTLEXP  EXPONENT FOR Independent interface states factor — 0  CTLW  Area dependence of interface states factor — 0  CTO  Geometry-independent interface states factor — 0  CTW  Width dependence of interface states factor — 0  CTW  Width dependence of interface states factor — 0  DELVTAC  Offset parameter for PHIB in separate charge calculation  DELVTACL  Length dependence of DELVTAC V 0  DELVTACLEXP  DELVTACL  Exponent for length dependence of offset of DELVTAC V 0  DELVTACLW  Area dependence of DELVTAC V 0  DELVTACO  Geom. independent offset parameter for PHIB in separate charge calculation V 0  DELVTACW  Width dependence of DELVTAC V 0  DELVTACW  Effective channel length reduction for CV W 0  DLQ  Effective channel length reduction for CV W 0  DLSIL  Silicide extension over the physical gate length W 0  DNSUB  Effective doping bias-dependence parameter V-1 0  DNSUB  Effective doping bias-dependence parameter V-1 0  DPHIB  Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL  Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELEXP  PHIB offset  DPHIBEDGELEXP  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELEXP  DPHIBEDGEL  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGEL  ORDERIEDGEL  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGEL  ORDERIEDGEL  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGEL  ORDERIEDGEL  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGEL   | CTEDGE        | Interface states factor of edge transistors         | _                | 0       |
| GENERALEZ factor of edge transistors  CTEDGEO  Geometry-independent interface states factor of edge transistors  CTL  Length dependence of interface states factor — 0  CTLEXP  Exponent for length dependence of interface states factor — 0  CTLEXP  Exponent for length dependence of interface states factor — 0  CTUW  Area dependence of interface states factor — 0  CTO  Geometry-independent interface states factor — 0  CTW  Width dependence of interface states factor — 0  DELVTAC  Offset parameter for PHIB in separate charge calculation  DELVTACL  Length dependence of DELVTAC V 0  DELVTACL  Exponent for length dependence of offset of DELVTAC V 0  DELVTACLW  Area dependence of DELVTAC V 0  DELVTACLW  Area dependence of DELVTAC V 0  DELVTACO  Geom. independent offset parameter for PHIB in separate charge calculation  DELVTACW  Width dependence of DELVTAC V 0  DLQ  Effective channel length reduction for CV m 0  DLSIL  Silicide extension over the physical gate length m 0  DNSUB  Effective doping bias-dependence parameter V-1 0  DNSUB  Effective doping bias-dependence parameter V-1 0  DPHIB  Offset parameter for PHIB of edge transistor V 0  DPHIBEDGEL  DPHIBEDGEL  Length dependence of edge transistor PHIB offset V 0  DPHIBEDGEL  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Width dependence of edge transistor PHIB offset V 0  DPHIBEDGELW  Width dependence of edge transistor PHIB offset V 0  | CTEDGEL       |   | _                | 0       |
| CTL Length dependence of interface states factor — 0  CTLEXP Exponent for length dependence of interface states factor — 1  CTLW Area dependence of interface states factor — 0  CTO Geometry-independent interface states factor — 0  CTW Width dependence of interface states factor — 0  CTW Width dependence of interface states factor — 0  DELVTAC Offset parameter for PHIB in separate charge calculation V 0  DELVTAC Length dependence of DELVTAC V 0  DELVTACL Length dependence of DELVTAC V 0  DELVTACL Area dependence of DELVTAC V 0  DELVTACL Sexponent for length dependence of offset of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation V 0  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSILL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB offset V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELEXP PHIB offset V 0  DPHIBEDGELEXP PHIB offset V 0  DPHIBEDGELEXP OFFICIAL | CTEDGELEXP    |   | _                | 1       |
| Exponent for length dependence of interface states factor  CTLW Area dependence of interface states factor — 0  CTO Geometry-independent interface states factor — 0  CTO Geometry-independent interface states factor — 0  CTW Width dependence of interface states factor — 0  DELVTAC Offset parameter for PHIB in separate charge calculation  DELVTAC Length dependence of DELVTAC V 0  DELVTACLEXP Exponent for length dependence of offset of DELVTAC V 0  DELVTACLEXP Area dependence of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB of edge transistors V 0  DPHIBEDGE Offset parameter for PHIB offset V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGELW Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGELW Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGELW Geometry independent of edge transistor PHIB offset V 0  | CTEDGEO       |   | _                | 0       |
| Factor  CTLW Area dependence of interface states factor — 0  CTO Geometry-independent interface states factor — 0  CTW Width dependence of interface states factor — 0  DELVTAC Offset parameter for PHIB in separate charge calculation V 0  DELVTACL Length dependence of DELVTAC V 0  DELVTACLEXP DELVTAC Exponent for length dependence of offset of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation V 0  DLQ Effective channel length reduction for CV M 0  DLSIL Silicide extension over the physical gate length M 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB V 0  DPHIB Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  | CTL           | Length dependence of interface states factor        | _                | 0       |
| CTO Geometry-independent interface states factor — 0  CTW Width dependence of interface states factor — 0  DELVTAC Offset parameter for PHIB in separate charge calculation V 0  DELVTACL Length dependence of DELVTAC V 0  DELVTACLEXP Exponent for length dependence of offset of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation V 0  DELVTACW Width dependence of DELVTAC V 0  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB V 0  DPHIBEDGE Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0  DPHIBEDGEW Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0  DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0  | CTLEXP        | · · · · · · · · · · · · · · · · · · ·               | _                | 1       |
| CTW       Width dependence of interface states factor       —       0         DELVTAC       Offset parameter for PHIB in separate charge calculation       V       0         DELVTACL       Length dependence of DELVTAC       V       0         DELVTACLEXP       Exponent for length dependence of offset of DELVTAC       V       0         DELVTACLW       Area dependence of DELVTAC       V       0         DELVTACO       Geom. independent offset parameter for PHIB in separate charge calculation       V       0         DELVTACW       Width dependence of DELVTAC       V       0         DLQ       Effective channel length reduction for CV       m       0         DLSIL       Silicide extension over the physical gate length       m       0         DNSUB       Effective doping bias-dependence parameter       V-1       0         DNSUBO       Effective doping bias-dependence parameter       V-1       0         DPHIB       Offset parameter for PHIB       V       0         DPHIBEDGE       Offset parameter for PHIB of edge transistors       V       0         DPHIBEDGEL       Length dependence of edge transistor PHIB offset       V       0         DPHIBEDGELW       Area dependence of edge transistor PHIB offset       V       0      <   | CTLW          | Area dependence of interface states factor          | _                | 0       |
| DELVTAC Offset parameter for PHIB in separate charge calculation  DELVTACL Length dependence of DELVTAC V 0  DELVTACLEXP Exponent for length dependence of offset of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation V 0  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUB Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB V 0  DPHIBEDGE Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELEXP Exponent for length dependence of edge transistor PHIB offset V 0  DPHIBEDGEL Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0   | CTO           | Geometry-independent interface states factor        | _                | 0       |
| DELVTACL Length dependence of DELVTAC V 0  DELVTACLEXP Exponent for length dependence of offset of DELVTAC V 0  DELVTACLW Area dependence of DELVTAC V 0  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation V 0  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB V 0  DPHIBEDGE Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0   | CTW           | Width dependence of interface states factor         | _                | 0       |
| DELVTACLEXP       Exponent for length dependence of offset of DELVTAC       —       1         DELVTACLW       Area dependence of DELVTAC       V       0         DELVTACO       Geom. independent offset parameter for PHIB in separate charge calculation       V       0         DELVTACW       Width dependence of DELVTAC       V       0         DLQ       Effective channel length reduction for CV       m       0         DLSIL       Silicide extension over the physical gate length       m       0         DNSUB       Effective doping bias-dependence parameter       V-1       0         DNSUBO       Effective doping bias-dependence parameter       V-1       0         DPHIB       Offset parameter for PHIB       V       0         DPHIB       Offset parameter for PHIB offege transistors       V       0         DPHIBEDGEL       Length dependence of edge transistor PHIB offset       V       0         DPHIBEDGELEXP       Exponent for length dependence of edge transistor PHIB offset       V       0         DPHIBEDGEO       Geometry independent of edge transistor PHIB offset       V       0         DPHIBEDGEW       Width dependence of edge transistor PHIB offset       V       0   | DELVTAC       | 1 2   | V                | 0       |
| DELVTAC  DELVTACLW Area dependence of DELVTAC  DELVTACO Geom. independent offset parameter for PHIB in separate charge calculation  DELVTACW Width dependence of DELVTAC V 0  DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO DEHIBE Offset parameter for PHIB Offset parameter for PHIB V 0  DPHIBEDGE Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL Exponent for length dependence of edge transistor PHIB offset  DPHIBEDGEL  Area dependence of edge transistor PHIB offset V 0  DPHIBEDGE Offset parameter for edge transistor PHIB offset V 0  DPHIBEDGE OFFINE OFF | DELVTACL      | Length dependence of DELVTAC                        | V                | 0       |
| DELVTACO  Geom. independent offset parameter for PHIB in separate charge calculation  DELVTACW  Width dependence of DELVTAC  V  0  DLQ  Effective channel length reduction for CV  m  0  DLSIL  Silicide extension over the physical gate length  m  0  DNSUB  Effective doping bias-dependence parameter  V-1  0  DNSUBO  Effective doping bias-dependence parameter  V-1  0  DPHIB  Offset parameter for PHIB  V  0  DPHIBEDGE  Offset parameter for PHIB of edge transistors  V  0  DPHIBEDGEL  Exponent for length dependence of edge transistor PHIB offset  V  0  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  V  0  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  0  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  0  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  0   | DELVTACLEXP   |   | _                | 1       |
| Separate charge calculation  DELVTACW  Width dependence of DELVTAC  V  DLQ  Effective channel length reduction for CV  m  DLSIL  Silicide extension over the physical gate length  DNSUB  Effective doping bias-dependence parameter  DNSUBO  Effective doping bias-dependence parameter  V-1  DPHIB  Offset parameter for PHIB  Offset parameter for PHIB  DPHIBEDGE  Offset parameter for PHIB of edge transistors  V  DPHIBEDGEL  Length dependence of edge transistor PHIB offset  V  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  V  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  O  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  O   | DELVTACLW     | Area dependence of DELVTAC                          | V                | 0       |
| DLQ Effective channel length reduction for CV m 0  DLSIL Silicide extension over the physical gate length m 0  DNSUB Effective doping bias-dependence parameter V-1 0  DNSUBO Effective doping bias-dependence parameter V-1 0  DPHIB Offset parameter for PHIB V 0  DPHIBEDGE Offset parameter for PHIB of edge transistors V 0  DPHIBEDGEL Length dependence of edge transistor PHIB offset V 0  DPHIBEDGELEXP Exponent for length dependence of edge transistor PHIB offset V 0  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEO Width dependence of edge transistor PHIB offset V 0   | DELVTACO      | •   | V                | 0       |
| DLSIL  Silicide extension over the physical gate length  M  O  DNSUB  Effective doping bias-dependence parameter  V-1  O  DNSUBO  Effective doping bias-dependence parameter  V-1  O  DPHIB  Offset parameter for PHIB  V  O  DPHIBEDGE  Offset parameter for PHIB of edge transistors  V  O  DPHIBEDGEL  Length dependence of edge transistor PHIB offset  V  O  DPHIBEDGELEXP  Exponent for length dependence of edge transistor  PHIB offset  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  V  O  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  O  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  O   | DELVTACW      | Width dependence of DELVTAC                         | V                | 0       |
| DNSUB  Effective doping bias-dependence parameter  DNSUBO  Effective doping bias-dependence parameter  DPHIB  Offset parameter for PHIB  Offset parameter for PHIB of edge transistors  DPHIBEDGEL  Length dependence of edge transistor PHIB offset  DPHIBEDGELEXP  Exponent for length dependence of edge transistor  PHIB offset  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW   | DLQ           | Effective channel length reduction for CV           | m                | 0       |
| DNSUBO  Effective doping bias-dependence parameter  V-1 0  DPHIB  Offset parameter for PHIB  DPHIBEDGE  Offset parameter for PHIB of edge transistors  V 0  DPHIBEDGEL  Length dependence of edge transistor PHIB offset  V 0  Exponent for length dependence of edge transistor  PHIB offset  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  V 0  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V 0  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V 0  | DLSIL         | Silicide extension over the physical gate length    | m                | 0       |
| DPHIBEDGEL  DPHIBEDGEL  DPHIBEDGEL  Coffset parameter for PHIB of edge transistors  DPHIBEDGEL  Length dependence of edge transistor PHIB offset  DPHIBEDGELEXP  Exponent for length dependence of edge transistor PHIB offset  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  DPHIBEDGEW  | DNSUB         | Effective doping bias-dependence parameter          | $V^{-1}$         | 0       |
| DPHIBEDGEL  DPHIBEDGEL  Length dependence of edge transistor PHIB offset  DPHIBEDGELEXP  Exponent for length dependence of edge transistor PHIB offset  DPHIBEDGELEXP  Area dependence of edge transistor PHIB offset  DPHIBEDGELW  Area dependence of edge transistor PHIB offset  V  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  O  DPHIBEDGEW   | DNSUBO        | Effective doping bias-dependence parameter          | $V^{-1}$         | 0       |
| DPHIBEDGEL  Length dependence of edge transistor PHIB offset  Exponent for length dependence of edge transistor PHIB offset  DPHIBEDGELEXP  Area dependence of edge transistor PHIB offset  V  0  DPHIBEDGEO  Geometry independent of edge transistor PHIB offset  V  0  DPHIBEDGEW  Width dependence of edge transistor PHIB offset  V  0   | DPHIB         | Offset parameter for PHIB                           | V                | 0       |
| DPHIBEDGELEXP       Exponent for length dependence of edge transistor PHIB offset       —       1         DPHIBEDGELW       Area dependence of edge transistor PHIB offset       V       0         DPHIBEDGEO       Geometry independent of edge transistor PHIB offset       V       0         DPHIBEDGEW       Width dependence of edge transistor PHIB offset       V       0   | DPHIBEDGE     | Offset parameter for PHIB of edge transistors       | V                | 0       |
| PHIB offset  DPHIBEDGELW Area dependence of edge transistor PHIB offset V 0  DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0  | DPHIBEDGEL    | Length dependence of edge transistor PHIB offset    | V                | 0       |
| DPHIBEDGEO Geometry independent of edge transistor PHIB offset V 0  DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0   | DPHIBEDGELEXP |   | _                | 1       |
| DPHIBEDGEW Width dependence of edge transistor PHIB offset V 0   | DPHIBEDGELW   | Area dependence of edge transistor PHIB offset      | V                | 0       |
|  | DPHIBEDGEO    | Geometry independent of edge transistor PHIB offset | V                | 0       |
| DPHIBL Length dependence offset of PHIB V 0  | DPHIBEDGEW    | Width dependence of edge transistor PHIB offset     | V                | 0       |
|  | DPHIBL        | Length dependence offset of PHIB                    | V                | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units              | Default |
|-------------|---|--------------------|---------|
| DPHIBLEXP   | Exponent for length dependence of offset of PHIB  | _                  | 1       |
| DPHIBLW     | Area dependence of offset of PHIB   | V                  | 0       |
| DPHIBO      | Geometry independent offset of PHIB   | V                  | 0       |
| DPHIBW      | Width dependence of offset of PHIB  | V                  | 0       |
| DTA         | Temperature offset w.r.t. ambient temperature   | K                  | 0       |
| DVSBNUD     | Vsb-range for NUD-effect  | V                  | 1       |
| DVSBNUDO    | Vsb range for NUD-effect  | V                  | 1       |
| DWQ         | Effective channel width reduction for CV  | m                  | 0       |
| EF          | Flicker noise frequency exponent  | _                  | 1       |
| EFEDGE      | Flicker noise frequency exponent of edge transistors  | _                  | 1       |
| EFEDGEO     | Flicker noise frequency exponent  | _                  | 1       |
| EFO         | Flicker noise frequency exponent  | _                  | 1       |
| EPSROX      | Relative permittivity of gate dielectric  | _                  | 3.9     |
| EPSROXO     | Relative permittivity of gate dielectric  | _                  | 3.9     |
| FACNEFFAC   | Pre-factor for effective substrate doping in separate charge calculation  | _                  | 1       |
| FACNEFFACL  | Length dependence of FACNEFFAC  | _                  | 0       |
| FACNEFFACLW | Area dependence of FACNEFFAC  | _                  | 0       |
| FACNEFFACO  | Geom. independent pre-factor for effective substrate doping in separate charge calculation  | _                  | 1       |
| FACNEFFACW  | Width dependence of FACNEFFAC   | _                  | 0       |
| FBBTRBOT    | Normalization field at the reference temperature for band-to-band tunneling of bottom component for source-bulk junction          | $ m Vm^{-1}$       | 1e+09   |
| FBBTRBOTD   | Normalization field at the reference temperature for band-to-band tunneling of bottom component for drain-bulk junction           | Vm <sup>-1</sup>   | 1e+09   |
| FBBTRGAT    | Normalization field at the reference temperature for<br>band-to-band tunneling of gate-edge component for<br>source-bulk junction | $\mathrm{Vm^{-1}}$ | 1e+09   |
| FBBTRGATD   | Normalization field at the reference temperature for<br>band-to-band tunneling of gate-edge component for<br>drain-bulk junction  | $\mathrm{Vm^{-1}}$ | 1e+09   |
| FBBTRSTI    | Normalization field at the reference temperature for<br>band-to-band tunneling of STI-edge component for<br>source-bulk junction  | $ m Vm^{-1}$       | 1e+09   |
| FBBTRSTID   | Normalization field at the reference temperature for<br>band-to-band tunneling of STI-edge component for<br>drain-bulk junction   | Vm <sup>-1</sup>   | 1e+09   |
| FBET1       | Relative mobility decrease due to first lateral profile   | _                  | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description  | Units            | Default |
|-------------|--|------------------|---------|
| FBET1W      | Width dependence of relative mobility decrease due to first lateral profile                          | _                | 0       |
| FBET2       | Relative mobility decrease due to second lateral profile   | _                | 0       |
| FBETEDGE    | Length dependence of edge transistor mobility  | _                | 0       |
| FETA        | Effective field parameter  | _                | 1       |
| FETAO       | Effective field parameter  | _                | 1       |
| FJUNQ       | Fraction below which source-bulk junction capacitance components are considered negligible           |                  | 0.03    |
| FJUNQD      | Fraction below which drain-bulk junction capacitance components are considered negligible            | _                | 0.03    |
| FNT         | Thermal noise coefficient  |                  | 1       |
| FNTEDGE     | Thermal noise coefficient of edge transistors  | _                | 1       |
| FNTEDGEO    | Thermal noise coefficient  | _                | 1       |
| FNTEXC      | Excess noise coefficient   | _                | 0       |
| FNTEXCL     | Length dependence coefficient of excess noise  | _                | 0       |
| FNTO        | Thermal noise coefficient  | _                | 1       |
| FOL1        | First length dependence coefficient for short channel body effect                                    | _                | 0       |
| FOL2        | Second length dependence coefficient for short channel body effect                                   | _                | 0       |
| FREV        | Coefficient for reverse breakdown current limitation   | _                | 1000    |
| GC2         | Gate current slope factor  | _                | 0.375   |
| GC20        | Gate current slope factor  | _                | 0.375   |
| GC3         | Gate current curvature factor  | _                | 0.063   |
| GC30        | Gate current curvature factor  | _                | 0.063   |
| GCO         | Gate tunnelling energy adjustment  | _                | 0       |
| GCOO        | Gate tunnelling energy adjustment  | _                | 0       |
| GFACNUD     | Body-factor change due to NUD-effect   | _                | 1       |
| GFACNUDL    | Length dependence of GFACNUD   | _                | 0       |
| GFACNUDLEXP | Exponent for length dependence of GFACNUD  | _                | 1       |
| GFACNUDLW   | Area dependence of GFACNUD   | _                | 0       |
| GFACNUDO    | Geom. independent body-factor change due to NUD-effect   | _                | 1       |
| GFACNUDW    | Width dependence of GFACNUD  | _                | 0       |
| IDSATRBOT   | Saturation current density at the reference temperature of bottom component for source-bulk junction | A/m <sup>2</sup> | 1e-12   |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter  | Description   | Units            | Default |
|------------|---|------------------|---------|
| IDSATRBOTD | Saturation current density at the reference temperature of bottom component for drain-bulk junction     | A/m <sup>2</sup> | 1e-12   |
| IDSATRGAT  | Saturation current density at the reference temperature of gate-edge component for source-bulk junction | A/m              | 1e-18   |
| IDSATRGATD | Saturation current density at the reference temperature of gate-edge component for drain-bulk junction  | A/m              | 1e-18   |
| IDSATRSTI  | Saturation current density at the reference temperature of STI-edge component for source-bulk junction  | A/m              | 1e-18   |
| IDSATRSTID | Saturation current density at the reference temperature of STI-edge component for drain-bulk junction   | A/m              | 1e-18   |
| IGINV      | Gate channel current pre-factor   | A                | 0       |
| IGINVLW    | Gate channel current pre-factor for 1 um**2 channel area  | A                | 0       |
| IGOV       | Gate overlap current pre-factor   | A                | 0       |
| IGOVD      | Gate overlap current pre-factor for drain side  | A                | 0       |
| IGOVDW     | Gate overlap current pre-factor for 1 um wide channel for drain side                                    | A                | 0       |
| IGOVW      | Gate overlap current pre-factor for 1 um wide channel   | A                | 0       |
| IMAX       | Maximum current up to which forward current behaves exponentially                                       | A                | 1000    |
| KUO        | Mobility degradation/enhancement coefficient  | m                | 0       |
| KUOWEL     | Length dependent mobility degradation factor  | _                | 0       |
| KUOWELW    | Area dependent mobility degradation factor  | _                | 0       |
| KUOWEO     | Geometrical independent mobility degradation factor   | _                | 0       |
| KUOWEW     | Width dependent mobility degradation factor   | _                | 0       |
| KVSAT      | Saturation velocity degradation/enhancement coefficient   | m                | 0       |
| KVTHO      | Threshold shift parameter   | Vm               | 0       |
| KVTHOWEL   | Length dependent threshold shift parameter  | _                | 0       |
| KVTHOWELW  | Area dependent threshold shift parameter  | _                | 0       |
| KVTHOWEO   | Geometrical independent threshold shift parameter   | _                | 0       |
| KVTHOWEW   | Width dependent threshold shift parameter   |                  | 0       |
| LAP        | Effective channel length reduction per side   | m                | 0       |
| LEVEL      | Model level   |                  | 103     |
| LINTNOI    | Length offset for flicker noise   | m                | 0       |
| LKUO       | Length dependence of KUO  | _                | 0       |
| LKVTHO     | Length dependence of KVTHO  |                  | 0       |
| LLODKUO    | Length parameter for UO stress effect   | _                | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| LLODVTH     | Length parameter for VTH-stress effect  | _     | 0       |
| LMAX        | Dummy parameter to label binning set  | m     | 1       |
| LMIN        | Dummy parameter to label binning set  | m     | 0       |
| LODETAO     | Eta0 shift modification factor for stress effect  | _     | 1       |
| LOV         | Overlap length for gate/drain and gate/source overlap capacitance   | m     | 0       |
| LOVD        | Overlap length for gate/drain overlap capacitance   | m     | 0       |
| LP1         | Mobility-related characteristic length of first lateral profile   | m     | 1e-08   |
| LP1W        | Width dependence of mobility-related characteristic length of first lateral profile                         |       | 0       |
| LP2         | Mobility-related characteristic length of second lateral profile  | m     | 1e-08   |
| LPCK        | Char. length of lateral doping profile  | m     | 1e-08   |
| LPCKW       | Width dependence of char. length of lateral doping profile  | _     | 0       |
| LPEDGE      | Exponent for length dependence of edge transistor mobility  | m     | 1e-08   |
| LVARL       | Length dependence of LVAR   | _     | 0       |
| LVARO       | Geom. independent difference between actual and programmed gate length                                      | m     | 0       |
| LVARW       | Width dependence of LVAR  | _     | 0       |
| MEFFTATBOT  | Effective mass (in units of m0) for trap-assisted tunneling of bottom component for source-bulk junction    | _     | 0.25    |
| MEFFTATBOTD | Effective mass (in units of m0) for trap-assisted tunneling of bottom component for drain-bulk junction     | _     | 0.25    |
| MEFFTATGAT  | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component for source-bulk junction | _     | 0.25    |
| MEFFTATGATD | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component for drain-bulk junction  | _     | 0.25    |
| MEFFTATSTI  | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component for source-bulk junction  | _     | 0.25    |
| MEFFTATSTID | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component for drain-bulk junction   | _     | 0.25    |
| MUE         | Mobility reduction coefficient at TR  | m/V   | 0.5     |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter  | Description  | Units             | Default |
|------------|--|-------------------|---------|
| MUEO       | Geometry independent mobility reduction coefficient at TR    | m/V               | 0.5     |
| MUEW       | Width dependence of mobility reduction coefficient at TR     | _                 | 0       |
| NEFF       | Effective substrate doping                                   | $\mathrm{m}^{-3}$ | 5e+23   |
| NEFFEDGE   | Effective substrate doping of edge transistors               | $\mathrm{m}^{-3}$ | 5e+23   |
| NFA        | First coefficient of flicker noise                           | _                 | 8e+22   |
| NFAEDGE    | First coefficient of flicker noise of edge transistors       | _                 | 8e+22   |
| NFAEDGELW  | First coefficient of flicker noise for 1 um**2 channel area  | _                 | 8e+22   |
| NFALW      | First coefficient of flicker noise for 1 um**2 channel area  | _                 | 8e+22   |
| NFB        | Second coefficient of flicker noise                          |                   | 3e+07   |
| NFBEDGE    | Second coefficient of flicker noise of edge transistors      |                   | 3e+07   |
| NFBEDGELW  | Second coefficient of flicker noise for 1 um**2 channel area |                   | 3e+07   |
| NFBLW      | Second coefficient of flicker noise for 1 um**2 channel area | _                 | 3e+07   |
| NFC        | Third coefficient of flicker noise                           | $V^{-1}$          | 0       |
| NFCEDGE    | Third coefficient of flicker noise of edge transistors       | $V^{-1}$          | 0       |
| NFCEDGELW  | Third coefficient of flicker noise for 1 um**2 channel area  | $V^{-1}$          | 0       |
| NFCLW      | Third coefficient of flicker noise for 1 um**2 channel area  | $V^{-1}$          | 0       |
| NOV        | Effective doping of overlap region                           | $\mathrm{m}^{-3}$ | 5e+25   |
| NOVD       | Effective doping of overlap region for drain side            | $\mathrm{m}^{-3}$ | 5e+25   |
| NOVDO      | Effective doping of overlap region for drain side            | $\mathrm{m}^{-3}$ | 5e+25   |
| NOVO       | Effective doping of overlap region                           | $\mathrm{m}^{-3}$ | 5e+25   |
| NP         | Gate poly-silicon doping                                     | $\mathrm{m}^{-3}$ | 1e+26   |
| NPCK       | Pocket doping level  | $\mathrm{m}^{-3}$ | 1e+24   |
| NPCKW      | Width dependence of pocket doping NPCK due to segregation    | _                 | 0       |
| NPL        | Length dependence of gate poly-silicon doping                |                   | 0       |
| NPO        | Geometry-independent gate poly-silicon doping                | $\mathrm{m}^{-3}$ | 1e+26   |
| NSLP       | Effective doping bias-dependence parameter                   | V                 | 0.05    |
| NSLPO      | Effective doping bias-dependence parameter                   | V                 | 0.05    |
| NSUBEDGEL  | Length dependence of edge transistor substrate doping        | _                 | 0       |
| NSUBEDGELW | Area dependence of edge transistor substrate doping          | _                 | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter | Description  | Units             | Default |
|-----------|--|-------------------|---------|
| NSUBEDGEO | Geometry independent substrate doping of edge transistors                        | $\mathrm{m}^{-3}$ | 5e+23   |
| NSUBEDGEW | Width dependence of edge transistor substrate doping                             | _                 | 0       |
| NSUBO     | Geometry independent substrate doping  | $\mathrm{m}^{-3}$ | 3e+23   |
| NSUBW     | Width dependence of background doping NSUBO due to segregation                   | _                 | 0       |
| PBOT      | Grading coefficient of bottom component for source-bulk junction                 | _                 | 0.5     |
| PBOTD     | Grading coefficient of bottom component for drain-bulk junction                  | _                 | 0.5     |
| PBRBOT    | Breakdown onset tuning parameter of bottom component for source-bulk junction    | V                 | 4       |
| PBRBOTD   | Breakdown onset tuning parameter of bottom component for drain-bulk junction     | V                 | 4       |
| PBRGAT    | Breakdown onset tuning parameter of gate-edge component for source-bulk junction | V                 | 4       |
| PBRGATD   | Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  | V                 | 4       |
| PBRSTI    | Breakdown onset tuning parameter of STI-edge component for source-bulk junction  | V                 | 4       |
| PBRSTID   | Breakdown onset tuning parameter of STI-edge component for drain-bulk junction   | V                 | 4       |
| PGAT      | Grading coefficient of gate-edge component for source-bulk junction              | _                 | 0.5     |
| PGATD     | Grading coefficient of gate-edge component for drain-bulk junction               | _                 | 0.5     |
| PHIGBOT   | Zero-temperature bandgap voltage of bottom component for source-bulk junction    | V                 | 1.16    |
| PHIGBOTD  | Zero-temperature bandgap voltage of bottom component for drain-bulk junction     | V                 | 1.16    |
| PHIGGAT   | Zero-temperature bandgap voltage of gate-edge component for source-bulk junction | V                 | 1.16    |
| PHIGGATD  | Zero-temperature bandgap voltage of gate-edge component for drain-bulk junction  | V                 | 1.16    |
| PHIGSTI   | Zero-temperature bandgap voltage of STI-edge component for source-bulk junction  | V                 | 1.16    |
| PHIGSTID  | Zero-temperature bandgap voltage of STI-edge component for drain-bulk junction   | V                 | 1.16    |
| PKUO      | Cross-term dependence of KUO   |                   | 0       |
| PKVTHO    | Cross-term dependence of KVTHO   |                   | 0       |
| PLA1      | Coefficient for the length dependence of A1                                      | _                 | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units                | Default |
|-------------|---|----------------------|---------|
| PLA3        | Coefficient for the length dependence of A3                   | _                    | 0       |
| PLA4        | Coefficient for the length dependence of A4                   | $V^{-1/2}$           | 0       |
| PLAGIDL     | Coefficient for the length dependence of AGIDL                | A/V <sup>3</sup>     | 0       |
| PLAGIDLD    | Coefficient for the length dependence of AGIDL for drain side | A/V <sup>3</sup>     | 0       |
| PLALP       | Coefficient for the length dependence of ALP                  | _                    | 0       |
| PLALP1      | Coefficient for the length dependence of ALP1                 | V                    | 0       |
| PLALP2      | Coefficient for the length dependence of ALP2                 | $V^{-1}$             | 0       |
| PLAX        | Coefficient for the length dependence of AX                   | _                    | 0       |
| PLBETN      | Coefficient for the length dependence of BETN                 | m <sup>2</sup> /(Vs) | 0       |
| PLBETNEDGE  | Coefficient for the length dependence of BETNEDGE             | m <sup>2</sup> /(Vs) | 0       |
| PLCF        | Coefficient for the length dependence of CF                   | _                    | 0       |
| PLCFEDGE    | Coefficient for the length dependence of CFEDGE               | _                    | 0       |
| PLCFR       | Coefficient for the length dependence of CFR                  | F                    | 0       |
| PLCFRD      | Coefficient for the length dependence of CFR for drain side   | F                    | 0       |
| PLCGBOV     | Coefficient for the length dependence of CGBOV                | F                    | 0       |
| PLCGOV      | Coefficient for the length dependence of CGOV                 | F                    | 0       |
| PLCGOVD     | Coefficient for the length dependence of CGOV for drain side  | F                    | 0       |
| PLCOX       | Coefficient for the length dependence of COX                  | F                    | 0       |
| PLCS        | Coefficient for the length dependence of CS                   | _                    | 0       |
| PLCT        | Coefficient for the length dependence of CT                   | _                    | 0       |
| PLCTEDGE    | Coefficient for the length dependence of CTEDGE               | _                    | 0       |
| PLDELVTAC   | Coefficient for the length dependence of DELVTAC              | V                    | 0       |
| PLDPHIB     | Coefficient for the length dependence of DPHIB                | V                    | 0       |
| PLDPHIBEDGE | Coefficient for the length dependence of DPHIBEDGE            | V                    | 0       |
| PLFACNEFFAC | Coefficient for the length dependence of FACNEFFAC            | _                    | 0       |
| PLFNTEXC    | Coefficient for the length dependence of FNTEXC               | _                    | 0       |
| PLGFACNUD   | Coefficient for the length dependence of GFACNUD              | _                    | 0       |
| PLIGINV     | Coefficient for the length dependence of IGINV                | A                    | 0       |
| PLIGOV      | Coefficient for the length dependence of IGOV                 | A                    | 0       |
| PLIGOVD     | Coefficient for the length dependence of IGOV for drain side  | A                    | 0       |
|             | Coefficient for the length dependence part of                 |                      |         |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units             | Default |
|-------------|---|-------------------|---------|
| PLKVTHOWE   | Coefficient for the length dependence part of KVTHOWE       | _                 | 0       |
| PLMUE       | Coefficient for the length dependence of MUE                | m/V               | 0       |
| PLNEFF      | Coefficient for the length dependence of NEFF               | $\mathrm{m}^{-3}$ | 0       |
| PLNEFFEDGE  | Coefficient for the length dependence of NEFFEDGE           | $\mathrm{m}^{-3}$ | 0       |
| PLNFA       | Coefficient for the length dependence of NFA                | _                 | 0       |
| PLNFAEDGE   | Coefficient for the length dependence of NFAEDGE            | _                 | 0       |
| PLNFB       | Coefficient for the length dependence of NFB                | _                 | 0       |
| PLNFBEDGE   | Coefficient for the length dependence of NFBEDGE            | _                 | 0       |
| PLNFC       | Coefficient for the length dependence of NFC                | $V^{-1}$          | 0       |
| PLNFCEDGE   | Coefficient for the length dependence of NFCEDGE            | $V^{-1}$          | 0       |
| PLNOV       | Coefficient for the length dependence of NOV                | $\mathrm{m}^{-3}$ | 0       |
| PLNOVD      | Coefficient for the length dependence of NOV for drain side | $\mathrm{m}^{-3}$ | 0       |
| PLNP        | Coefficient for the length dependence of NP                 | $\mathrm{m}^{-3}$ | 0       |
| PLPSCE      | Coefficient for the length dependence of PSCE               |                   | 0       |
| PLPSCEEDGE  | Coefficient for the length dependence of PSCEEDGE           |                   | 0       |
| PLRS        | Coefficient for the length dependence of RS                 | Ω                 | 0       |
| PLSTBET     | Coefficient for the length dependence of STBET              | _                 | 0       |
| PLSTBETEDGE | Coefficient for the length dependence of STBETEDGE          | _                 | 0       |
| PLSTTHESAT  | Coefficient for the length dependence of STTHESAT           |                   | 0       |
| PLSTVFB     | Coefficient for the length dependence of STVFB              | V/K               | 0       |
| PLSTVFBEDGE | Coefficient for the length dependence of STVFBEDGE          | V/K               | 0       |
| PLTHESAT    | Coefficient for the length dependence of THESAT             | $V^{-1}$          | 0       |
| PLTHESATB   | Coefficient for the length dependence of THESATB            | $V^{-1}$          | 0       |
| PLTHESATG   | Coefficient for the length dependence of THESATG            | $V^{-1}$          | 0       |
| PLVFB       | Coefficient for the length dependence of VFB                | V                 | 0       |
| PLWA1       | Coefficient for the length times width dependence of A1     | _                 | 0       |
| PLWA3       | Coefficient for the length times width dependence of A3     | _                 | 0       |
| PLWA4       | Coefficient for the length times width dependence of A4     | $V^{-1/2}$        | 0       |
| PLWAGIDL    | Coefficient for the length times width dependence of AGIDL  | A/V <sup>3</sup>  | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter    | Description   | Units                | Default |
|--------------|---|----------------------|---------|
| PLWAGIDLD    | Coefficient for the length times width dependence of AGIDL for drain side | A/V <sup>3</sup>     | 0       |
| PLWALP       | Coefficient for the length times width dependence of ALP                  | _                    | 0       |
| PLWALP1      | Coefficient for the length times width dependence of ALP1                 | V                    | 0       |
| PLWALP2      | Coefficient for the length times width dependence of ALP2                 | $V^{-1}$             | 0       |
| PLWAX        | Coefficient for the length times width dependence of AX                   | _                    | 0       |
| PLWBETN      | Coefficient for the length times width dependence of BETN                 | m <sup>2</sup> /(Vs) | 0       |
| PLWBETNEDGE  | Coefficient for the length times width dependence of BETNEDGE             | m <sup>2</sup> /(Vs) | 0       |
| PLWCF        | Coefficient for the length times width dependence of CF                   | _                    | 0       |
| PLWCFEDGE    | Coefficient for the length times width dependence of CFEDGE               | _                    | 0       |
| PLWCFR       | Coefficient for the length times width dependence of CFR                  | F                    | 0       |
| PLWCFRD      | Coefficient for the length times width dependence of CFR for drain side   | F                    | 0       |
| PLWCGBOV     | Coefficient for the length times width dependence of CGBOV                | F                    | 0       |
| PLWCGOV      | Coefficient for the length times width dependence of CGOV                 | F                    | 0       |
| PLWCGOVD     | Coefficient for the length times width dependence of CGOV for drain side  | F                    | 0       |
| PLWCOX       | Coefficient for the length times width dependence of COX                  | F                    | 0       |
| PLWCS        | Coefficient for the length times width dependence of CS                   | _                    | 0       |
| PLWCT        | Coefficient for the length times width dependence of CT                   | _                    | 0       |
| PLWCTEDGE    | Coefficient for the length times width dependence of CTEDGE               | _                    | 0       |
| PLWDELVTAC   | Coefficient for the length times width dependence of DELVTAC              | V                    | 0       |
| PLWDPHIB     | Coefficient for the length times width dependence of DPHIB                | V                    | 0       |
| PLWDPHIBEDGE | Coefficient for the length times width dependence of DPHIBEDGE            | V                    | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter    | Description  | Units             | Default |
|--------------|--|-------------------|---------|
| PLWFACNEFFAC | Coefficient for the length times width dependence of FACNEFFAC           | _                 | 0       |
| PLWFNTEXC    | Coefficient for the length times width dependence of FNTEXC              | _                 | 0       |
| PLWGFACNUD   | Coefficient for the length times width dependence of GFACNUD             | _                 | 0       |
| PLWIGINV     | Coefficient for the length times width dependence of IGINV               | A                 | 0       |
| PLWIGOV      | Coefficient for the length times width dependence of IGOV                | A                 | 0       |
| PLWIGOVD     | Coefficient for the length times width dependence of IGOV for drain side | A                 | 0       |
| PLWKUOWE     | Coefficient for the length times width dependence part of KUOWE          | _                 | 0       |
| PLWKVTHOWE   | Coefficient for the length times width dependence part of KVTHOWE        | _                 | 0       |
| PLWMUE       | Coefficient for the length times width dependence of MUE                 | m/V               | 0       |
| PLWNEFF      | Coefficient for the length times width dependence of NEFF                | $m^{-3}$          | 0       |
| PLWNEFFEDGE  | Coefficient for the length times width dependence of NEFFEDGE            | $\mathrm{m}^{-3}$ | 0       |
| PLWNFA       | Coefficient for the length times width dependence of NFA                 | _                 | 0       |
| PLWNFAEDGE   | Coefficient for the length times width dependence of NFAEDGE             |                   | 0       |
| PLWNFB       | Coefficient for the length times width dependence of NFB                 | _                 | 0       |
| PLWNFBEDGE   | Coefficient for the length times width dependence of NFBEDGE             | _                 | 0       |
| PLWNFC       | Coefficient for the length times width dependence of NFC                 | $V^{-1}$          | 0       |
| PLWNFCEDGE   | Coefficient for the length times width dependence of NFCEDGE             | $V^{-1}$          | 0       |
| PLWNOV       | Coefficient for the length times width dependence of NOV                 | $\mathrm{m}^{-3}$ | 0       |
| PLWNOVD      | Coefficient for the length times width dependence of NOV for drain side  | $\mathrm{m}^{-3}$ | 0       |
| PLWNP        | Coefficient for the length times width dependence of NP                  | $m^{-3}$          | 0       |
| PLWPSCE      | Coefficient for the length times width dependence of PSCE                | _                 | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter    | Description   | Units                | Default |
|--------------|---|----------------------|---------|
| PLWPSCEEDGE  | Coefficient for the length times width dependence of PSCEEDGE         | _                    | 0       |
| PLWRS        | Coefficient for the length times width dependence of RS               | Ω                    | 0       |
| PLWSTBET     | Coefficient for the length times width dependence of STBET            | _                    | 0       |
| PLWSTBETEDGE | Coefficient for the length times width dependence of STBETEDGE        | _                    | 0       |
| PLWSTTHESAT  | Coefficient for the length times width dependence of STTHESAT         | _                    | 0       |
| PLWSTVFB     | Coefficient for the length times width dependence of STVFB            | V/K                  | 0       |
| PLWSTVFBEDGE | Coefficient for the length times width dependence of STVFBEDGE        | V/K                  | 0       |
| PLWTHESAT    | Coefficient for the length times width dependence of THESAT           | $V^{-1}$             | 0       |
| PLWTHESATB   | Coefficient for the length times width dependence of THESATB          | $V^{-1}$             | 0       |
| PLWTHESATG   | Coefficient for the length times width dependence of THESATG          | $V^{-1}$             | 0       |
| PLWVFB       | Coefficient for the length times width dependence of VFB              | V                    | 0       |
| PLWXCOR      | Coefficient for the length times width dependence of XCOR             | $V^{-1}$             | 0       |
| PLXCOR       | Coefficient for the length dependence of XCOR                         | $V^{-1}$             | 0       |
| POA1         | Coefficient for the geometry independent part of A1                   | _                    | 1       |
| POA2         | Coefficient for the geometry independent part of A2                   | V                    | 10      |
| POA3         | Coefficient for the geometry independent part of A3                   | _                    | 1       |
| POA4         | Coefficient for the geometry independent part of A4                   | $V^{-1/2}$           | 0       |
| POAGIDL      | Coefficient for the geometry independent part of AGIDL                | A/V <sup>3</sup>     | 0       |
| POAGIDLD     | Coefficient for the geometry independent part of AGIDL for drain side | A/V <sup>3</sup>     | 0       |
| POALP        | Coefficient for the geometry independent part of ALP                  | _                    | 0.01    |
| POALP1       | Coefficient for the geometry independent part of ALP1                 | V                    | 0       |
| POALP2       | Coefficient for the geometry independent part of ALP2                 | $V^{-1}$             | 0       |
| POAX         | Coefficient for the geometry independent part of AX                   | _                    | 3       |
| POBETN       | Coefficient for the geometry independent part of BETN                 | m <sup>2</sup> /(Vs) | 0.07    |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter  | Description   | Units                | Default |
|------------|---|----------------------|---------|
| POBETNEDGE | Coefficient for the geometry independent part of BETNEDGE             | m <sup>2</sup> /(Vs) | 0.0005  |
| POBGIDL    | Coefficient for the geometry independent part of BGIDL                | V                    | 41      |
| POBGIDLD   | Coefficient for the geometry independent part of BGIDL for drain side | V                    | 41      |
| POCF       | Coefficient for the geometry independent part of CF                   | _                    | 0       |
| POCFB      | Coefficient for the geometry independent part of CFB                  | $V^{-1}$             | 0       |
| POCFBEDGE  | Coefficient for the geometry independent part of CFBEDGE              | $V^{-1}$             | 0       |
| POCFD      | Coefficient for the geometry independent part of CFD                  | $V^{-1}$             | 0       |
| POCFDEDGE  | Coefficient for the geometry independent part of CFDEDGE              | $V^{-1}$             | 0       |
| POCFEDGE   | Coefficient for the geometry independent part of CFEDGE               | _                    | 0       |
| POCFR      | Coefficient for the geometry independent part of CFR                  | F                    | 0       |
| POCFRD     | Coefficient for the geometry independent part of CFR for drain side   | F                    | 0       |
| POCGBOV    | Coefficient for the geometry independent part of CGBOV                | F                    | 0       |
| POCGIDL    | Coefficient for the geometry independent part of CGIDL                | _                    | 0       |
| POCGIDLD   | Coefficient for the geometry independent part of CGIDL for drain side | _                    | 0       |
| POCGOV     | Coefficient for the geometry independent part of CGOV                 | F                    | 1e-15   |
| POCGOVD    | Coefficient for the geometry independent part of CGOV for drain side  | F                    | 1e-15   |
| POCHIB     | Coefficient for the geometry independent part of CHIB                 | V                    | 3.1     |
| POCOX      | Coefficient for the geometry independent part of COX                  | F                    | 1e-14   |
| POCS       | Coefficient for the geometry independent part of CS                   |                      | 0       |
| POCT       | Coefficient for the geometry independent part of CT                   |                      | 0       |
| POCTEDGE   | Coefficient for the geometry independent part of CTEDGE               | _                    | 0       |
| PODELVTAC  | Coefficient for the geometry independent part of DELVTAC              | V                    | 0       |
| PODNSUB    | Coefficient for the geometry independent part of DNSUB                | $V^{-1}$             | 0       |
| PODPHIB    | Coefficient for the geometry independent part of DPHIB                | V                    | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description  | Units             | Default |
|-------------|--|-------------------|---------|
| PODPHIBEDGE | Coefficient for the geometry independent part of DPHIBEDGE           | V                 | 0       |
| PODVSBNUD   | Coefficient for the geometry independent part of DVSBNUD             | V                 | 1       |
| POEF        | Coefficient for the flicker noise frequency exponent                 | _                 | 1       |
| POEFEDGE    | Coefficient for the geometry independent part of EFEDGE              | _                 | 1       |
| POEPSROX    | Coefficient for the geometry independent part of EPSOX               | _                 | 3.9     |
| POFACNEFFAC | Coefficient for the geometry independent part of FACNEFFAC           | _                 | 1       |
| POFETA      | Coefficient for the geometry independent part of FETA                | _                 | 1       |
| POFNT       | Coefficient for the geometry independent part of FNT                 |                   | 1       |
| POFNTEDGE   | Coefficient for the geometry independent part of FNTEDGE             | _                 | 1       |
| POFNTEXC    | Coefficient for the geometry independent part of FNTEXC              | _                 | 0       |
| POGC2       | Coefficient for the geometry independent part of GC2                 | _                 | 0.375   |
| POGC3       | Coefficient for the geometry independent part of GC3                 | _                 | 0.063   |
| POGCO       | Coefficient for the geometry independent part of GCO                 | _                 | 0       |
| POGFACNUD   | Coefficient for the geometry independent part of GFACNUD             | _                 | 1       |
| POIGINV     | Coefficient for the geometry independent part of IGINV               | A                 | 0       |
| POIGOV      | Coefficient for the geometry independent part of IGOV                | A                 | 0       |
| POIGOVD     | Coefficient for the geometry independent part of IGOV for drain side | A                 | 0       |
| POKUOWE     | Coefficient for the geometry independent part of KUOWE               | _                 | 0       |
| POKVTHOWE   | Coefficient for the geometry independent part of KVTHOWE             | _                 | 0       |
| POMUE       | Coefficient for the geometry independent part of MUE                 | m/V               | 0.5     |
| PONEFF      | Coefficient for the geometry independent part of NEFF                | $m^{-3}$          | 5e+23   |
| PONEFFEDGE  | Coefficient for the geometry independent part of NEFFEDGE            | $\mathrm{m}^{-3}$ | 5e+23   |
| PONFA       | Coefficient for the geometry independent part of NFA                 | _                 | 8e+22   |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units             | Default |
|-------------|---|-------------------|---------|
| PONFAEDGE   | Coefficient for the geometry independent part of NFAEDGE                | _                 | 8e+22   |
| PONFB       | Coefficient for the geometry independent part of NFB                    | _                 | 3e+07   |
| PONFBEDGE   | Coefficient for the geometry independent part of NFBEDGE                | _                 | 3e+07   |
| PONFC       | Coefficient for the geometry independent part of NFC                    | $V^{-1}$          | 0       |
| PONFCEDGE   | Coefficient for the geometry independent part of NFCEDGE                | $V^{-1}$          | 0       |
| PONOV       | Coefficient for the geometry independent part of NOV                    | $\mathrm{m}^{-3}$ | 5e+25   |
| PONOVD      | Coefficient for the geometry independent part of NOV for drain side     | $\mathrm{m}^{-3}$ | 5e+25   |
| PONP        | Coefficient for the geometry independent part of NP                     | $\mathrm{m}^{-3}$ | 1e+26   |
| PONSLP      | Coefficient for the geometry independent part of NSLP                   | V                 | 0.05    |
| POPSCE      | Coefficient for the geometry independent part of PSCE                   | _                 | 0       |
| POPSCEB     | Coefficient for the geometry independent part of PSCEB                  | $V^{-1}$          | 0       |
| POPSCEBEDGE | Coefficient for the geometry independent part of PSCEBEDGE              | $V^{-1}$          | 0       |
| POPSCED     | Coefficient for the geometry independent part of PSCED                  | $V^{-1}$          | 0       |
| POPSCEDEDGE | Coefficient for the geometry independent part of PSCEDEDGE              | $V^{-1}$          | 0       |
| POPSCEEDGE  | Coefficient for the geometry independent part of PSCEEDGE               | _                 | 0       |
| PORS        | Coefficient for the geometry independent part of RS                     | Ω                 | 30      |
| PORSB       | Coefficient for the geometry independent part of RSB                    | $V^{-1}$          | 0       |
| PORSG       | Coefficient for the geometry independent part of RSG                    | $V^{-1}$          | 0       |
| POSTA2      | Coefficient for the geometry independent part of STA2                   | V                 | 0       |
| POSTBET     | Coefficient for the geometry independent part of STBET                  | _                 | 1       |
| POSTBETEDGE | Coefficient for the geometry independent part of STBETEDGE              | _                 | 1       |
| POSTBGIDL   | Coefficient for the geometry independent part of STBGIDL                | V/K               | 0       |
| POSTBGIDLD  | Coefficient for the geometry independent part of STBGIDL for drain side | V/K               | 0       |
| POSTCS      | Coefficient for the geometry independent part of STCS                   | _                 | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units    | Default |
|-------------|---|----------|---------|
| POSTIG      | Coefficient for the geometry independent part of STIG                 | _        | 2       |
| POSTMUE     | Coefficient for the geometry independent part of STMUE                | _        | 0       |
| POSTRS      | Coefficient for the geometry independent part of STRS                 | _        | 1       |
| POSTTHEMU   | Coefficient for the geometry independent part of STTHEMU              | _        | 1.5     |
| POSTTHESAT  | Coefficient for the geometry independent part of STTHESAT             | _        | 1       |
| POSTVFB     | Coefficient for the geometry independent part of STVFB                | V/K      | 0.0005  |
| POSTVFBEDGE | Coefficient for the geometry independent part of STVFBEDGE            | V/K      | 0       |
| POSTXCOR    | Coefficient for the geometry independent part of STXCOR               |          | 0       |
| POTHEMU     | Coefficient for the geometry independent part of THEMU                |          | 1.5     |
| POTHESAT    | Coefficient for the geometry independent part of THESAT               | $V^{-1}$ | 1       |
| POTHESATB   | Coefficient for the geometry independent part of THESATB              | $V^{-1}$ | 0       |
| POTHESATG   | Coefficient for the geometry independent part of THESATG              | $V^{-1}$ | 0       |
| POTOX       | Coefficient for the geometry independent part of TOX                  | m        | 2e-09   |
| POTOXOV     | Coefficient for the geometry independent part of TOXOV                | m        | 2e-09   |
| POTOXOVD    | Coefficient for the geometry independent part of TOXOV for drain side | m        | 2e-09   |
| POVFB       | Coefficient for the geometry independent part of VFB                  | V        | -1      |
| POVFBEDGE   | Coefficient for the geometry independent part of VFBEDGE              | V        | -1      |
| POVNSUB     | Coefficient for the geometry independent part of VNSUB                | V        | 0       |
| POVP        | Coefficient for the geometry independent part of VP                   | V        | 0.05    |
| POVSBNUD    | Coefficient for the geometry independent part of VSBNUD               | V        | 0       |
| POXCOR      | Coefficient for the geometry independent part of XCOR                 | $V^{-1}$ | 0       |
| PSCE        | Subthreshold slope coefficient for short channel transistor           | _        | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter    | Description   | Units            | Default |
|--------------|---|------------------|---------|
| PSCEB        | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel transistor        | $V^{-1}$         | 0       |
| PSCEBEDGE    | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors  | $V^{-1}$         | 0       |
| PSCEBEDGEO   | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors  | $V^{-1}$         | 0       |
| PSCEBO       | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel transistor        | $V^{-1}$         | 0       |
| PSCED        | Drain voltage dependence parameter of subthreshold slope coefficient for short channel transistor       | $V^{-1}$         | 0       |
| PSCEDEDGE    | Drain voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors | $V^{-1}$         | 0       |
| PSCEDEDGEO   | Drain voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors | $V^{-1}$         | 0       |
| PSCEDO       | Drain voltage dependence parameter of subthreshold slope coefficient for short channel transistor       | $V^{-1}$         | 0       |
| PSCEEDGE     | Subthreshold slope coefficient for short channel edge transistors                                       | _                | 0       |
| PSCEEDGEL    | Length dependence of subthreshold slope coefficient for short channel edge transistors                  | _                | 0       |
| PSCEEDGELEXP | Exponent for length dependence of subthreshold slope coefficient for short channel edge transistors     | _                | 2       |
| PSCEEDGEW    | Exponent for length dependence of subthreshold slope coefficient for short channel edge transistor      | _                | 0       |
| PSCEL        | Length dependence of subthreshold slope coefficient for short channel transistor                        | _                | 0       |
| PSCELEXP     | Exponent for length dependence of subthreshold slope coefficient for short channel transistor           | _                | 2       |
| PSCEW        | Exponent for length dependence of subthreshold slope coefficient for short channel transistor           | _                | 0       |
| PSTI         | Grading coefficient of STI-edge component for source-bulk junction                                      | _                | 0.5     |
| PSTID        | Grading coefficient of STI-edge component for drain-bulk junction                                       | _                | 0.5     |
| PWA1         | Coefficient for the width dependence of A1  | _                | 0       |
| PWA3         | Coefficient for the width dependence of A3  | _                | 0       |
| PWA4         | Coefficient for the width dependence of A4  | $V^{-1/2}$       | 0       |
| PWAGIDL      | Coefficient for the width dependence of AGIDL   | A/V <sup>3</sup> | 0       |
| PWAGIDLD     | Coefficient for the width dependence of AGIDL for drain side  | $A/V^3$          | 0       |
| PWALP        | Coefficient for the width dependence of ALP   | _                | 0       |
|              |   |                  |         |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description   | Units                | Default |
|-------------|---|----------------------|---------|
| PWALP1      | Coefficient for the width dependence of ALP1                | V                    | 0       |
| PWALP2      | Coefficient for the width dependence of ALP2                | $V^{-1}$             | 0       |
| PWAX        | Coefficient for the width dependence of AX                  | _                    | 0       |
| PWBETN      | Coefficient for the width dependence of BETN                | m <sup>2</sup> /(Vs) | 0       |
| PWBETNEDGE  | Coefficient for the width dependence of BETNEDGE            | m <sup>2</sup> /(Vs) | 0       |
| PWCF        | Coefficient for the width dependence of CF                  | _                    | 0       |
| PWCFEDGE    | Coefficient for the width dependence of CFEDGE              | _                    | 0       |
| PWCFR       | Coefficient for the width dependence of CFR                 | F                    | 0       |
| PWCFRD      | Coefficient for the width dependence of CFR for drain side  | F                    | 0       |
| PWCGBOV     | Coefficient for the width dependence of CGBOV               | F                    | 0       |
| PWCGOV      | Coefficient for the width dependence of CGOV                | F                    | 0       |
| PWCGOVD     | Coefficient for the width dependence of CGOV for drain side | F                    | 0       |
| PWCOX       | Coefficient for the width dependence of COX                 | F                    | 0       |
| PWCS        | Coefficient for the width dependence of CS                  |                      | 0       |
| PWCT        | Coefficient for the width dependence of CT                  | _                    | 0       |
| PWCTEDGE    | Coefficient for the width dependence of CTEDGE              | _                    | 0       |
| PWDELVTAC   | Coefficient for the width dependence of DELVTAC             | V                    | 0       |
| PWDPHIB     | Coefficient for the width dependence of DPHIB               | V                    | 0       |
| PWDPHIBEDGE | Coefficient for the width dependence of DPHIBEDGE           | V                    | 0       |
| PWFACNEFFAC | Coefficient for the width dependence of FACNEFFAC           | _                    | 0       |
| PWFNTEXC    | Coefficient for the width dependence of FNTEXC              | _                    | 0       |
| PWGFACNUD   | Coefficient for the width dependence of GFACNUD             | _                    | 0       |
| PWIGINV     | Coefficient for the width dependence of IGINV               | A                    | 0       |
| PWIGOV      | Coefficient for the width dependence of IGOV                | A                    | 0       |
| PWIGOVD     | Coefficient for the width dependence of IGOV for drain side | A                    | 0       |
| PWKUOWE     | Coefficient for the width dependence part of KUOWE          |                      | 0       |
| PWKVTHOWE   | Coefficient for the width dependence part of KVTHOWE        | _                    | 0       |
| PWMUE       | Coefficient for the width dependence of MUE                 | m/V                  | 0       |
| PWNEFF      | Coefficient for the width dependence of NEFF                | $\mathrm{m}^{-3}$    | 0       |
| PWNEFFEDGE  | Coefficient for the width dependence of NEFFEDGE            | $\mathrm{m}^{-3}$    | 0       |
| PWNFA       | Coefficient for the width dependence of NFA                 |                      | 0       |
| PWNFAEDGE   | Coefficient for the width dependence of NFAEDGE             | _                    | 0       |
| PWNFB       | Coefficient for the width dependence of NFB                 |                      | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description  | Units             | Default |
|-------------|--|-------------------|---------|
| PWNFBEDGE   | Coefficient for the width dependence of NFBEDGE            | _                 | 0       |
| PWNFC       | Coefficient for the width dependence of NFC                | $V^{-1}$          | 0       |
| PWNFCEDGE   | Coefficient for the width dependence of NFCEDGE            | $V^{-1}$          | 0       |
| PWNOV       | Coefficient for the width dependence of NOV                | $\mathrm{m}^{-3}$ | 0       |
| PWNOVD      | Coefficient for the width dependence of NOV for drain side | $\mathrm{m}^{-3}$ | 0       |
| PWNP        | Coefficient for the width dependence of NP                 | $\mathrm{m}^{-3}$ | 0       |
| PWPSCE      | Coefficient for the width dependence of PSCE               | _                 | 0       |
| PWPSCEEDGE  | Coefficient for the width dependence of PSCEEDGE           | _                 | 0       |
| PWRS        | Coefficient for the width dependence of RS                 | Ω                 | 0       |
| PWSTBET     | Coefficient for the width dependence of STBET              | _                 | 0       |
| PWSTBETEDGE | Coefficient for the width dependence of STBETEDGE          | _                 | 0       |
| PWSTTHESAT  | Coefficient for the width dependence of STTHESAT           | _                 | 0       |
| PWSTVFB     | Coefficient for the width dependence of STVFB              | V/K               | 0       |
| PWSTVFBEDGE | Coefficient for the width dependence of STVFBEDGE          | V/K               | 0       |
| PWTHESAT    | Coefficient for the width dependence of THESAT             | $V^{-1}$          | 0       |
| PWTHESATB   | Coefficient for the width dependence of THESATB            | $V^{-1}$          | 0       |
| PWTHESATG   | Coefficient for the width dependence of THESATG            | $V^{-1}$          | 0       |
| PWVFB       | Coefficient for the width dependence of VFB                | V                 | 0       |
| PWXCOR      | Coefficient for the width dependence of XCOR               | $V^{-1}$          | 0       |
| QMC         | Quantum-mechanical correction factor                       | _                 | 1       |
| RBULK       | Bulk resistance between node BP and BI                     | Ω                 | 0       |
| RBULKO      | Bulk resistance between node BP and BI                     | Ω                 | 0       |
| RDE         | External drain resistance                                  | Ω                 | 0       |
| RG          | Gate resistance  | Ω                 | 0       |
| RGO         | Gate resistance  | Ω                 | 0       |
| RINT        | Contact resistance between silicide and ploy               | $\Omega  m^2$     | 0       |
| RJUND       | Drain-side bulk resistance between node BI and BD          | Ω                 | 0       |
| RJUNDO      | Drain-side bulk resistance between node BI and BD          | Ω                 | 0       |
| RJUNS       | Source-side bulk resistance between node BI and BS         | Ω                 | 0       |
| RJUNSO      | Source-side bulk resistance between node BI and BS         | Ω                 | 0       |
| RS          | Series resistance at TR                                    | Ω                 | 30      |
| RSB         | Back-bias dependence of series resistance                  | $V^{-1}$          | 0       |
| RSBO        | Back-bias dependence of series resistance                  | $V^{-1}$          | 0       |
| RSE         | External source resistance                                 | Ω                 | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description  | Units         | Default |
|-------------|--|---------------|---------|
| RSG         | Gate-bias dependence of series resistance                    | $V^{-1}$      | 0       |
| RSGO        | Gate-bias dependence of series resistance                    | $V^{-1}$      | 0       |
| RSH         | Sheet resistance of source diffusion                         | $\Omega/\Box$ | 0       |
| RSHD        | Sheet resistance of drain diffusion                          | $\Omega/\Box$ | 0       |
| RSHG        | Gate electrode diffusion sheet resistance                    | $\Omega/\Box$ | 0       |
| RSW1        | Source/drain series resistance for 1 um wide channel at TR   | Ω             | 50      |
| RSW2        | Higher-order width scaling of RS                             | _             | 0       |
| RVPOLY      | Vertical poly resistance                                     | $\Omega  m^2$ | 0       |
| RWELL       | Well resistance between node BI and B                        | Ω             | 0       |
| RWELLO      | Well resistance between node BI and B                        | Ω             | 0       |
| SAREF       | Reference distance between OD-edge and poly from one side    | m             | 1e-06   |
| SBREF       | Reference distance between OD-edge and poly from other side  | m             | 1e-06   |
| SCREF       | Distance between OD-edge and well edge of a reference device | m             | 1e-06   |
| STA2        | Temperature dependence of A2                                 | V             | 0       |
| STA20       | Temperature dependence of A2                                 | V             | 0       |
| STBET       | Temperature dependence of BETN                               | _             | 1       |
| STBETEDGE   | Temperature dependence of BETNEDGE                           | _             | 1       |
| STBETEDGEL  | Length dependence of temperature dependence of BETNEDGE      | _             | 0       |
| STBETEDGELW | Area dependence of temperature dependence of BETNEDGE        | _             | 0       |
| STBETEDGEO  | Geometry independent temperature dependence of BETNEDGE      | _             | 1       |
| STBETEDGEW  | Width dependence of temperature dependence of BETNEDGE       | _             | 0       |
| STBETL      | Length dependence of temperature dependence of BETN          | _             | 0       |
| STBETLW     | Area dependence of temperature dependence of BETN            | _             | 0       |
| STBETO      | Geometry independent temperature dependence of BETN          | _             | 1       |
| STBETW      | Width dependence of temperature dependence of BETN           | _             | 0       |
| STBGIDL     | Temperature dependence of BGIDL                              | V/K           | 0       |
| STBGIDLD    | Temperature dependence of BGIDL for drain side               | V/K           | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| STBGIDLDO  | Temperature dependence of BGIDL for drain side   | V/K   | 0       |
| STBGIDLO   | Temperature dependence of BGIDL  | V/K   | 0       |
| STCS       | Temperature dependence of CS   | _     | 0       |
| STCSO      | Temperature dependence of CS   | _     | 0       |
| STETAO     | Eta0 shift factor related to VTHO change   | m     | 0       |
| STFBBTBOT  | Temperature scaling parameter for band-to-band tunneling of bottom component for source-bulk junction    | 1/K   | -0.001  |
| STFBBTBOTD | Temperature scaling parameter for band-to-band tunneling of bottom component for drain-bulk junction     | 1/K   | -0.001  |
| STFBBTGAT  | Temperature scaling parameter for band-to-band tunneling of gate-edge component for source-bulk junction | 1/K   | -0.001  |
| STFBBTGATD | Temperature scaling parameter for band-to-band tunneling of gate-edge component for drain-bulk junction  | 1/K   | -0.001  |
| STFBBTSTI  | Temperature scaling parameter for band-to-band tunneling of STI-edge component for source-bulk junction  | 1/K   | -0.001  |
| STFBBTSTID | Temperature scaling parameter for band-to-band tunneling of STI-edge component for drain-bulk junction   | 1/K   | -0.001  |
| STIG       | Temperature dependence of IGINV and IGOV   | _     | 2       |
| STIGO      | Temperature dependence of IGINV and IGOV   | _     | 2       |
| STMUE      | Temperature dependence of MUE  | _     | 0       |
| STMUEO     | Temperature dependence of MUE  | _     | 0       |
| STRS       | Temperature dependence of RS   | _     | 1       |
| STRSO      | Temperature dependence of RS   | _     | 1       |
| STTHEMU    | Temperature dependence of THEMU  | _     | 1.5     |
| STTHEMUO   | Temperature dependence of THEMU  | _     | 1.5     |
| STTHESAT   | Temperature dependence of THESAT   | _     | 1       |
| STTHESATL  | Length dependence of temperature dependence of THESAT  |       | 0       |
| STTHESATLW | Area dependence of temperature dependence of THESAT  | _     | 0       |
| STTHESATO  | Geometry independent temperature dependence of THESAT  |       | 1       |
| STTHESATW  | Width dependence of temperature dependence of THESAT   | _     | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter   | Description  | Units    | Default |
|-------------|--|----------|---------|
| STVFB       | Temperature dependence of VFB                            | V/K      | 0.0005  |
| STVFBEDGE   | Temperature dependence of VFBEDGE                        | V/K      | 0.0005  |
| STVFBEDGEL  | Length dependence of temperature dependence of VFBEDGE   | V/K      | 0       |
| STVFBEDGELW | Area dependence of temperature dependence of VFBEDGE     | V/K      | 0       |
| STVFBEDGEO  | Geometry-independent temperature dependence of VFBEDGE   | V/K      | 0.0005  |
| STVFBEDGEW  | Width dependence of temperature dependence of VFBEDGE    | V/K      | 0       |
| STVFBL      | Length dependence of temperature dependence of VFB       | V/K      | 0       |
| STVFBLW     | Area dependence of temperature dependence of VFB         | V/K      | 0       |
| STVFBO      | Geometry-independent temperature dependence of VFB       | V/K      | 0.0005  |
| STVFBW      | Width dependence of temperature dependence of VFB        | V/K      | 0       |
| STXCOR      | Temperature dependence of XCOR                           | _        | 0       |
| STXCORO     | Temperature dependence of XCOR                           | _        | 0       |
| SWDELVTAC   | Flag for separate capacitance calculation; 0=off, 1=on   | _        | 0       |
| SWEDGE      | Flag for drain current of edge transistors; 0=off, 1=on  | _        | 0       |
| SWGEO       | Flag for geometrical model, 0=local, 1=global, 2=binning | _        | 1       |
| SWGIDL      | Flag for GIDL current, 0=turn off IGIDL                  | _        | 0       |
| SWIGATE     | Flag for gate current, 0=turn off IG                     | _        | 0       |
| SWIGN       | Flag for induced gate noise; 0=off, 1=on                 | _        | 1       |
| SWIMPACT    | Flag for impact ionization current, 0=turn off II        | _        | 0       |
| SWJUNASYM   | Flag for asymmetric junctions; 0=symmetric, 1=asymmetric | _        | 0       |
| SWJUNCAP    | Flag for juncap, 0=turn off juncap                       |          | 0       |
| SWJUNEXP    | Flag for JUNCAP-express; 0=full model, 1=express model   | _        | 0       |
| SWNUD       | Flag for NUD-effect; 0=off, 1=on, 2=on+CV-correction     | _        | 0       |
| THEMU       | Mobility reduction exponent at TR                        | _        | 1.5     |
| THEMUO      | Mobility reduction exponent at TR                        | _        | 1.5     |
| THESAT      | Velocity saturation parameter at TR                      | $V^{-1}$ | 1       |
| THESATB     | Back-bias dependence of velocity saturation              | $V^{-1}$ | 0       |
| THESATBO    | Back-bias dependence of velocity saturation              | $V^{-1}$ | 0       |
| THESATG     | Gate-bias dependence of velocity saturation              | $V^{-1}$ | 0       |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter  | Description   | Units                | Default |
|------------|---|----------------------|---------|
| THESATGO   | Gate-bias dependence of velocity saturation   | $V^{-1}$             | 0       |
| THESATL    | Length dependence of THESAT   | $V^{-1}$             | 0.05    |
| THESATLEXP | Exponent for length dependence of THESAT  | _                    | 1       |
| THESATLW   | Area dependence of velocity saturation parameter  | _                    | 0       |
| THESATO    | Geometry independent velocity saturation parameter at TR                                      | $V^{-1}$             | 0       |
| THESATW    | Width dependence of velocity saturation parameter   | _                    | 0       |
| TKUO       | Temperature dependence of KUO   | _                    | 0       |
| TOX        | Gate oxide thickness  | m                    | 2e-09   |
| TOXO       | Gate oxide thickness  | m                    | 2e-09   |
| TOXOV      | Overlap oxide thickness   | m                    | 2e-09   |
| TOXOVD     | Overlap oxide thickness for drain side  | m                    | 2e-09   |
| TOXOVDO    | Overlap oxide thickness for drain side  | m                    | 2e-09   |
| TOXOVO     | Overlap oxide thickness   | m                    | 2e-09   |
| TR         | nominal (reference) temperature   | °C                   | 21      |
| TRJ        | Reference temperature   | °C                   | 21      |
| TYPE       | Channel type parameter, +1=NMOS -1=PMOS   | _                    | 1       |
| UO         | Zero-field mobility at TR   | m <sup>2</sup> /(Vs) | 0.05    |
| VBIRBOT    | Built-in voltage at the reference temperature of bottom component for source-bulk junction    | V                    | 1       |
| VBIRBOTD   | Built-in voltage at the reference temperature of bottom component for drain-bulk junction     | V                    | 1       |
| VBIRGAT    | Built-in voltage at the reference temperature of gate-edge component for source-bulk junction | V                    | 1       |
| VBIRGATD   | Built-in voltage at the reference temperature of gate-edge component for drain-bulk junction  | V                    | 1       |
| VBIRSTI    | Built-in voltage at the reference temperature of STI-edge component for source-bulk junction  | V                    | 1       |
| VBIRSTID   | Built-in voltage at the reference temperature of STI-edge component for drain-bulk junction   | V                    | 1       |
| VBRBOT     | Breakdown voltage of bottom component for source-bulk junction                                | V                    | 10      |
| VBRBOTD    | Breakdown voltage of bottom component for drain-bulk junction                                 | V                    | 10      |
| VBRGAT     | Breakdown voltage of gate-edge component for source-bulk junction                             | V                    | 10      |
| VBRGATD    | Breakdown voltage of gate-edge component for drain-bulk junction                              | V                    | 10      |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| VBRSTI    | Breakdown voltage of STI-edge component for source-bulk junction   | V     | 10      |
| VBRSTID   | Breakdown voltage of STI-edge component for drain-bulk junction    | V     | 10      |
| VFB       | Flat band voltage at TR  | V     | -1      |
| VFBEDGE   | Flat band voltage of edge transistors at TR                        | V     | -1      |
| VFBEDGEO  | Geometry-independent flat-band voltage of edge transistors at TR   | V     | -1      |
| VFBL      | Length dependence of flat-band voltage                             | V     | 0       |
| VFBLW     | Area dependence of flat-band voltage                               | V     | 0       |
| VFBO      | Geometry-independent flat-band voltage at TR                       | V     | -1      |
| VFBW      | Width dependence of flat-band voltage                              | V     | 0       |
| VJUNREF   | Typical maximum source-bulk junction voltage; usually about 2*VSUP | V     | 2.5     |
| VJUNREFD  | Typical maximum drain-bulk junction voltage; usually about 2*VSUP  | V     | 2.5     |
| VNSUB     | Effective doping bias-dependence parameter                         | V     | 0       |
| VNSUBO    | Effective doping bias-dependence parameter                         | V     | 0       |
| VP        | CLM logarithm dependence factor                                    | V     | 0.05    |
| VPO       | CLM logarithmic dependence parameter                               | V     | 0.05    |
| VSBNUD    | Lower Vsb value for NUD-effect                                     | V     | 0       |
| VSBNUDO   | Lower Vsb value for NUD-effect                                     | V     | 0       |
| WBET      | Characteristic width for width scaling of BETN                     | m     | 1e-09   |
| WEB       | Coefficient for SCB  | _     | 0       |
| WEC       | Coefficient for SCC  | _     | 0       |
| WEDGE     | Electrical width of edge transistor per side                       | m     | 1e-08   |
| WEDGEW    | Width dependence of edge WEDGE                                     | _     | 0       |
| WKUO      | Width dependence of KUO  | _     | 0       |
| WKVTHO    | Width dependence of KVTHO  | _     | 0       |
| WLOD      | Width parameter  | m     | 0       |
| WLODKUO   | Width parameter for UO stress effect                               |       | 0       |
| WLODVTH   | Width parameter for VTH-stress effect                              | _     | 0       |
| WMAX      | Dummy parameter to label binning set                               | m     | 1       |
| WMIN      | Dummy parameter to label binning set                               | m     | 0       |
| WOT       | Effective channel width reduction per side                         | m     | 0       |
| WSEG      | Char. length of segregation of background doping NSUBO             | m     | 1e-08   |
| WSEGP     | Char. length of segregation of pocket doping NPCK                  | m     | 1e-08   |

Table 2-119. PSP103VA MOSFET Device Model Parameters

| Parameter | Description  | Units    | Default |
|-----------|--|----------|---------|
| WVARL     | Length dependence of WVAR  | _        | 0       |
| WVARO     | Geom. independent difference between actual and programmed field-oxide opening | m        | 0       |
| WVARW     | Width dependence of WVAR   | _        | 0       |
| XCOR      | Non-universality factor  | $V^{-1}$ | 0       |
| XCORL     | Length dependence of non-universality parameter                                | _        | 0       |
| XCORLW    | Area dependence of non-universality parameter                                  | _        | 0       |
| XCORO     | Geometry independent non-universality parameter                                | $V^{-1}$ | 0       |
| XCORW     | Width dependence of non-universality parameter                                 | _        | 0       |
| XJUNGAT   | Junction depth of gate-edge component for source-bulk junction                 | m        | 1e-07   |
| XJUNGATD  | Junction depth of gate-edge component for drain-bulk junction                  | m        | 1e-07   |
| XJUNSTI   | Junction depth of STI-edge component for source-bulk junction                  | m        | 1e-07   |
| XJUNSTID  | Junction depth of STI-edge component for drain-bulk junction                   | m        | 1e-07   |

Table 2-120. MOSFET level 103 Output Variables

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| ctype     | Flag for channel type   |       | none    |
| sdint     | Flag for source-drain interchange   |       | none    |
| ise       | Total source current  | A     | none    |
| ige       | Total gate current  | A     | none    |
| ide       | Total drain current   | A     | none    |
| ibe       | Total bulk current  | A     | none    |
| ids       | Drain current, excl. edge transistor currents, avalanche, tunnel, GISL, GIDL, and junction currents | A     | none    |
| idb       | Drain to bulk current   | A     | none    |
| isb       | Source to bulk current  | A     | none    |
| igs       | Gate-source tunneling current   | A     | none    |
| igd       | Gate-drain tunneling current  | A     | none    |
| igb       | Gate-bulk tunneling current   | A     | none    |
| idedge    | Drain current of edge transistors   | A     | none    |
| igcs      | Gate-channel tunneling current (source component)   | A     | none    |
| igcd      | Gate-channel tunneling current (drain component)  | A     | none    |
| iavl      | Substrate current due to weak avelanche   | A     | none    |

Table 2-120. MOSFET level 103 Output Variables

| Parameter | Description   | Units         | Default |
|-----------|---|---------------|---------|
| igisl     | Gate-induced source leakage current                                     | A             | none    |
| igidl     | Gate-induced drain leakage current                                      | A             | none    |
| ijs       | Total source junction current   | A             | none    |
| ijsbot    | Source junction current (bottom component)                              | A             | none    |
| ijsgat    | Source junction current (gate-edge component)                           | A             | none    |
| ijssti    | Source junction current (STI-edge component)                            | A             | none    |
| ijd       | Total drain junction current  | A             | none    |
| ijdbot    | Drain junction current (bottom component)                               | A             | none    |
| ijdgat    | Drain junction current (gate-edge component)                            | A             | none    |
| ijdsti    | Drain junction current (STI-edge component)                             | A             | none    |
| vds       | Drain-source voltage  | V             | none    |
| vgs       | Gate-source voltage   | V             | none    |
| vsb       | Source-bulk voltage   | V             | none    |
| vto       | Zero-bias threshold voltage   | V             | none    |
| vts       | Threshold voltage including back bias effects                           | V             | none    |
| vth       | Threshold voltage including back bias and drain bias effects            | V             | none    |
| vgt       | Effective gate drive voltage including back bias and drain bias effects | V             | none    |
| vdss      | Drain saturation voltage at actual bias                                 | V             | none    |
| vsat      | Saturation limit  |               | none    |
| gm        | Transconductance  | $\Omega^{-1}$ | none    |
| gmb       | Substrate transconductance  | $\Omega^{-1}$ | none    |
| gds       | Output conductance  | $\Omega^{-1}$ | none    |
| gjs       | Source junction conductance   | $\Omega^{-1}$ | none    |
| gjd       | Drain junction conductance  | $\Omega^{-1}$ | none    |
| cdd       | Drain capacitance   | F             | none    |
| cdg       | Drain-gate capacitance  | F             | none    |
| cds       | Drain-source capacitance  | F             | none    |
| cdb       | Drain-bulk capacitance  | F             | none    |
| <br>cgd   | Gate-drain capacitance  | F             | none    |
| cgg       | Gate capacitance  | F             | none    |
| cgs       | Gate-source capacitance   | F             | none    |
| J         |   | Б             | none    |
| cgb       | Gate-bulk capacitance   | F             | HOHE    |
|           | Gate-bulk capacitance Source-drain capacitance                          | F             | none    |

Table 2-120. MOSFET level 103 Output Variables

| Parameter | Description  | Units              | Default |
|-----------|--|--------------------|---------|
| css       | Source capacitance   | F                  | none    |
| csb       | Source-bulk capacitance  | F                  | none    |
| cbd       | Bulk-drain capacitance   | F                  | none    |
| cbg       | Bulk-gate capacitance  | F                  | none    |
| cbs       | Bulk-source capacitance  | F                  | none    |
| cbb       | Bulk capacitance   | F                  | none    |
| cgsol     | Total gate-source overlap capacitance                            | F                  | none    |
| cgdol     | Total gate-drain overlap capacitance                             | F                  | none    |
| cjs       | Total source junction capacitance                                | F                  | none    |
| cjsbot    | Source junction capacitance (bottom component)                   | F                  | none    |
| cjsgat    | Source junction capacitance (gate-edge component)                | F                  | none    |
| cjssti    | Source junction capacitance (STI-edge component)                 | F                  | none    |
| ejd       | Total drain junction capacitance                                 | F                  | none    |
| cjdbot    | Drain junction capacitance (bottom component)                    | F                  | none    |
| cjdgat    | Drain junction capacitance (gate-edge component)                 | F                  | none    |
| cjdsti    | Drain junction capacitance (STI-edge component)                  | F                  | none    |
| weff      | Effective channel width for geometrical models                   | m                  | none    |
| leff      | Effective channel length for geometrical models                  | m                  | none    |
| 1         | Transistor gain  |                    | none    |
| rout      | Small-signal output resistance                                   | Ohm                | none    |
| vearly    | Equivalent Early voltage   | V                  | none    |
| peff      | Gain factor  | A/V <sup>2</sup>   | none    |
| fug       | Unity gain frequency at actual bias                              | Hz                 | none    |
| rg        | Gate resistance  | Ohm                | none    |
| sfl       | Flicker noise current spectral density at 1 Hz                   | A <sup>2</sup> /Hz | none    |
| sqrtsff   | Input-referred RMS white noise voltage spectral density at 1 kHz | V/sqrt(Hz)         | none    |
| sqrtsfw   | Input-referred RMS white noise voltage spectral density          | V/sqrt(Hz)         | none    |
| sid       | White noise current spectral density                             | A <sup>2</sup> /Hz | none    |
| sig       | Induced gate noise current spectral density at 1 Hz              | A <sup>2</sup> /Hz | none    |
| cigid     | Imaginary part of correlation coefficient between Sig and Sid    |                    | none    |
| fknee     | Cross-over frequency above which white noise is dominant         | Hz                 | none    |
| sigs      | Gate-source current noise spectral density                       | A <sup>2</sup> /Hz | none    |
| sigd      | Gate-drain current noise spectral density                        | A <sup>2</sup> /Hz | none    |

Table 2-120. MOSFET level 103 Output Variables

| Parameter    | Description  | Units                 | Default |
|--------------|--|-----------------------|---------|
| siavl        | Impact ionization current noise spectral density                   | A <sup>2</sup> /Hz    | none    |
| ssi          | Total source junction current noise spectral density               | A <sup>2</sup> /Hz    | none    |
| sdi          | Total drain junction current noise spectral density                | A <sup>2</sup> /Hz    | none    |
| sfledge      | Flicker noise current spectral density at 1 Hz of edge transistors | A <sup>2</sup> /Hz    | none    |
| sidedge      | White noise current spectral density of edge transistors           | A <sup>2</sup> /Hz    | none    |
| lp_vfb       | Local parameter VFB after T-scaling and clipping                   | V                     | none    |
| lp_stvfb     | Local parameter STVFB after clipping                               | V/K                   | none    |
| lp_tox       | Local parameter TOX after clipping                                 | m                     | none    |
| lp_epsrox    | Local parameter EPSROX after clipping                              |                       | none    |
| lp_neff      | Local parameter NEFF after clipping                                | $m^{-3}$              | none    |
| lp_facneffac | Local parameter FACNEFFAC after clipping                           |                       | none    |
| lp_gfacnud   | Local parameter GFACNUD after clipping                             |                       | none    |
| lp_vsbnud    | Local parameter VSBNUD after clipping                              | V                     | none    |
| lp_dvsbnud   | Local parameter DVSBNUD after clipping                             | V                     | none    |
| lp_vnsub     | Local parameter VNSUB after clipping                               | V                     | none    |
| lp_nslp      | Local parameter NSLP after clipping                                | V                     | none    |
| lp_dnsub     | Local parameter DNSUB after clipping                               | $V^{-1}$              | none    |
| lp_dphib     | Local parameter DPHIB after clipping                               | V                     | none    |
| lp_delvtac   | Local parameter DELVTAC after clipping                             | V                     | none    |
| lp_np        | Local parameter NP after clipping                                  | $\mathrm{m}^{-3}$     | none    |
| lp_ct        | Local parameter CT after clipping                                  |                       | none    |
| lp_toxov     | Local parameter TOXOV after clipping                               | m                     | none    |
| lp_toxovd    | Local parameter TOXOVD after clipping                              | m                     | none    |
| lp_nov       | Local parameter NOV after clipping                                 | $\mathrm{m}^{-3}$     | none    |
| lp_novd      | Local parameter NOVD after clipping                                | $\mathrm{m}^{-3}$     | none    |
| lp_cf        | Local parameter CF after clipping                                  |                       | none    |
| lp_cfd       | Local parameter CFD after clipping                                 | $V^{-1}$              | none    |
| lp_cfb       | Local parameter CFB after clipping                                 | $V^{-1}$              | none    |
| lp_psce      | Local parameter PSCE after clipping                                |                       | none    |
| lp_psceb     | Local parameter PSCEB after clipping                               | $V^{-1}$              | none    |
| lp_psced     | Local parameter PSCED after clipping                               | $V^{-1}$              | none    |
| lp_betn      | Local parameter BETN after T-scaling and clipping                  | m <sup>2</sup> /(V s) | none    |
| lp_stbet     | Local parameter STBET after clipping                               |                       | none    |
| lp_mue       | Local parameter MUE after T-scaling and clipping                   | m/V                   | none    |

Table 2-120. MOSFET level 103 Output Variables

| 1p_stmue         Local parameter STMUE after clipping         none           1p_stthemu         Local parameter THEMU after Ciscaling and clipping         none           1p_stthemu         Local parameter STTHEMU after Clipping         none           1p_stcs         Local parameter STCS after clipping         none           1p_stcs         Local parameter STCS after clipping         rone           1p_stcor         Local parameter STXCOR after clipping         v-1         none           1p_stcor         Local parameter STXCOR after clipping         v-1         none           1p_stcor         Local parameter STXCOR after clipping         one         none           1p_stc         Local parameter STRS after clipping         one         none           1p_stc         Local parameter STRS after clipping         V-1         none           1p_stc         Local parameter STRS after clipping         V-1         none           1p_stc         Local parameter THESAT after clipping         V-1         none           1p_std         Local parameter THESAT after clipping         V-1         none           1p_stbesatb         Local parameter THESAT after clipping         V-1         none           1p_stbesatb         Local parameter AX after clipping         V-1         none <tr< th=""><th>Parameter</th><th>Description</th><th>Units</th><th>Default</th></tr<>   | Parameter   | Description   | Units            | Default |
|--|-------------|---|------------------|---------|
| 1p_stthemu         Local parameter STHEMU after clipping         none           1p_cs         Local parameter CS after T-scaling and clipping         none           1p_stcs         Local parameter STCS after clipping         none           1p_stcor         Local parameter STCS after clipping         none           1p_stxcor         Local parameter STXCOR after clipping         none           1p_stcor         Local parameter STTGS after clipping         none           1p_stca         Local parameter RS after T-scaling and clipping         Ohm         none           1p_strs         Local parameter RSB after clipping         V-1         none           1p_rsb         Local parameter RSG after clipping         V-1         none           1p_stbesat         Local parameter RSG after clipping         V-1         none           1p_sthesat         Local parameter STTHESAT after clipping         V-1         none           1p_stbesat         Local parameter STTHESAT after clipping         V-1         none           1p_stbesat         Local parameter THESATG after clipping         V-1         none           1p_stbesat         Local parameter THESATG after clipping         V-1         none           1p_alp         Local parameter ALP after clipping         V-1         none  | lp_stmue    | Local parameter STMUE after clipping                |                  | none    |
| lp_csc         Local parameter CS after T-scaling and clipping         none           lp_stcs         Local parameter STCS after clipping         none           lp_stcor         Local parameter XCOR after T-scaling and clipping         V-1         none           lp_stxcor         Local parameter STXCOR after clipping         none           lp_feta         Local parameter STX after clipping         none           lp_rs         Local parameter RS after T-scaling and clipping         Ohm         none           lp_strs         Local parameter RS after clipping         V-1         none           lp_strs         Local parameter RSB after clipping         V-1         none           lp_strs         Local parameter RSB after clipping         V-1         none           lp_sts         Local parameter RSB after clipping         V-1         none           lp_thesat         Local parameter THESAT after clipping         V-1         none           lp_thesatb         Local parameter THESATG after clipping         V-1         none           lp_thesatb         Local parameter THESATG after clipping         V-1         none           lp_thesatb         Local parameter AX after clipping         V-1         none           lp_ast         Local parameter AX after clipping         V-1         n   | lp_themu    | Local parameter THEMU after T-scaling and clipping  |                  | none    |
| lp_stcs         Local parameter STCS after clipping         V-1         none           lp_stxcor         Local parameter XCOR after T-scaling and clipping         V-1         none           lp_stxcor         Local parameter STXCOR after clipping         none           lp_stx         Local parameter FSTA after clipping         none           lp_rs         Local parameter RSB after clipping         Ohm         none           lp_strs         Local parameter RSB after clipping         V-1         none           lp_rsg         Local parameter RSB after clipping         V-1         none           lp_rsg         Local parameter RSB after clipping         V-1         none           lp_sthesat         Local parameter THESAT after clipping         V-1         none           lp_thesatb         Local parameter THESATG after clipping         V-1         none           lp_thesatb         Local parameter THESATG after clipping         V-1         none           lp_thesatc         Local parameter AX after clipping         V-1         none           lp_thesatc         Local parameter AX after clipping         V-1         none           lp_aax         Local parameter AX after clipping         V         none           lp_alp         Local parameter ALP1 after clipping         V </td <td>lp_stthemu</td> <td>Local parameter STTHEMU after clipping</td> <td></td> <td>none</td>   | lp_stthemu  | Local parameter STTHEMU after clipping              |                  | none    |
| lp_xcor         Local parameter XCOR after T-scaling and clipping         V-1         none           lp_stxcor         Local parameter STXCOR after clipping         none           lp_feta         Local parameter FETA after clipping         none           lp_rs         Local parameter RS after T-scaling and clipping         Ohm         none           lp_strs         Local parameter RSB after clipping         V-1         none           lp_rsb         Local parameter RSB after clipping         V-1         none           lp_thesat         Local parameter RSB after clipping         V-1         none           lp_sthesat         Local parameter STTHESAT after clipping         V-1         none           lp_sthesat         Local parameter STTHESAT after clipping         V-1         none           lp_sthesat         Local parameter STTHESAT after clipping         V-1         none           lp_sthesat         Local parameter THESATG after clipping         V-1         none           lp_sthesat         Local parameter THESATG after clipping         V-1         none           lp_sthesat         Local parameter AX after clipping         V-1         none           lp_alp         Local parameter ALP1 after clipping         V         none           lp_alp         Local parameter ALP2 aft   | lp_cs       | Local parameter CS after T-scaling and clipping     |                  | none    |
| D_stxcor   Local parameter STXCOR after clipping   none     D_feta   Local parameter FETA after clipping   none     D_rs   Local parameter RS after T-scaling and clipping   Ohm   none     D_rst   Local parameter RSB after clipping   Ohm   none     D_rst   Local parameter RSB after clipping   V-1   none     D_rst   Local parameter RSB after clipping   V-1   none     D_rst   Local parameter RSB after clipping   V-1   none     D_rst   Local parameter THESAT after T-scaling and clipping   V-1   none     D_pst   Local parameter THESAT after clipping   N-1   none     D_pst   Local parameter Ax after clipping   N-1   none     D_pax   Local parameter Ax after clipping   N-1   none     D_past   Local parameter GX after clipping   N-1   none     D_past   Local parameter GX after clipping   N-1   none     D_past   Local parameter GX after clipping   N-1   none     D_past   Local parameter S | lp_stcs     | Local parameter STCS after clipping                 |                  | none    |
| lp_feta         Local parameter FETA after clipping         none           lp_rs         Local parameter RS after T-scaling and clipping         Ohm         none           lp_strs         Local parameter STRS after clipping         V-1         none           lp_rsb         Local parameter RSB after clipping         V-1         none           lp_tsg         Local parameter RSG after clipping         V-1         none           lp_thesat         Local parameter STHESAT after clipping         V-1         none           lp_thesatb         Local parameter STHESATB after clipping         V-1         none           lp_thesatb         Local parameter ALP after clipping         V-1         none           lp_thesatb         Local parameter ALP after clipping         V-1         none           lp_athesatb         Local parameter ALP after clipping         V-1         none           lp_athesatb         Local parameter ALP after clipping         V-1         none           lp_athesatb         Local parameter ALP after clipping         V-1         none           lp_a1p         Local parameter ALP after clipping         V-1         none           lp_a1p2         Local parameter ALP after clipping         V-1         none           lp_val         Local parameter ALP after clippi  | lp_xcor     | Local parameter XCOR after T-scaling and clipping   | $V^{-1}$         | none    |
| 1p_rs         Local parameter RS after T-scaling and clipping         Ohm         none           1p_strs         Local parameter STRS after clipping         V^-1         none           1p_rsb         Local parameter RSB after clipping         V^-1         none           1p_tsg         Local parameter RSG after clipping         V^-1         none           1p_thesat         Local parameter STHESAT after T-scaling and clipping         V^-1         none           1p_thesatb         Local parameter STHESAT after clipping         V^-1         none           1p_thesatb         Local parameter ALSATG after clipping         V^-1         none           1p_thesatg         Local parameter ALSATG after clipping         V^-1         none           1p_ax         Local parameter ALPath after clipping         V^-1         none           1p_ax         Local parameter ALPather clipping         V         none           1p_va         Local parameter ALPather clipping         V         none           1p_ax         Local parameter ALPat   | lp_stxcor   | Local parameter STXCOR after clipping               |                  | none    |
| lp_strs         Local parameter STRS after clipping         v-1         none           lp_rsb         Local parameter RSB after clipping         V-1         none           lp_rsg         Local parameter RSG after clipping         V-1         none           lp_thesat         Local parameter THESAT after T-scaling and clipping         V-1         none           lp_sthesatb         Local parameter STTHESAT after clipping         V-1         none           lp_thesatg         Local parameter THESATG after clipping         V-1         none           lp_ax         Local parameter AX after clipping         V-1         none           lp_a1p         Local parameter ALP after clipping         V-1         none           lp_a1p         Local parameter ALP after clipping         None         none           lp_a1p         Local parameter ALP after clipping         Vonone         none           lp_a1p         Local parameter ALP after clipping         Vonone         none           lp_a1p         Local parameter ALP after clipping         Vonone         none           lp_a2p         Local parameter ALP after clipping         Vonone         none           lp_a3         Local parameter ALP after clipping         None         none           lp_a3         Local parameter A   | lp_feta     | Local parameter FETA after clipping                 |                  | none    |
| lp_rsb         Local parameter RSB after clipping         V <sup>-1</sup> none           lp_rsg         Local parameter RSG after clipping         V <sup>-1</sup> none           lp_thesat         Local parameter THESAT after T-scaling and clipping         V <sup>-1</sup> none           lp_stthesat         Local parameter STTHESAT after clipping         V <sup>-1</sup> none           lp_thesatb         Local parameter THESATB after clipping         V <sup>-1</sup> none           lp_thesatg         Local parameter THESATG after clipping         V <sup>-1</sup> none           lp_ax         Local parameter AX after clipping         V <sup>-1</sup> none           lp_ax         Local parameter ALP after clipping         V         none           lp_alp         Local parameter ALP after clipping         V         none           lp_asta2         Local parameter STA2 after clipping         V         none           lp_asta4         Lo   | lp_rs       | Local parameter RS after T-scaling and clipping     | Ohm              | none    |
| D_rsg  | lp_strs     | Local parameter STRS after clipping                 |                  | none    |
| Ip_thesat         Local parameter THESAT after T-scaling and clipping         V-1         none           Ip_stthesat         Local parameter STTHESAT after clipping         V-1         none           Ip_thesatb         Local parameter THESATB after clipping         V-1         none           Ip_thesatg         Local parameter THESATG after clipping         V-1         none           Ip_ax         Local parameter ALP after clipping         V-1         none           Ip_a1p         Local parameter ALP after clipping         V         none           Ip_a1p         Local parameter ALP after clipping         V         none           Ip_a1p2         Local parameter ALP after clipping         V         none           Ip_a1p2         Local parameter VP after clipping         V         none           Ip_a1p2         Local parameter VP after clipping         V         none           Ip_a2         Local parameter ALP after clipping         V         none           Ip_a3         Local parameter STA2 after clipping         V         none           Ip_a4         Local parameter AL after clipping         I/sqrt(V)         none           Ip_a5         Local parameter GCO after clipping         A         none           Ip_igov         Local parameter IGOVD after T-scal   | lp_rsb      | Local parameter RSB after clipping                  | $V^{-1}$         | none    |
| Local parameter STHESAT after clipping   Local parameter STHESAT after clipping   V-1   none   | lp_rsg      | Local parameter RSG after clipping                  | $V^{-1}$         | none    |
| 1p_thesatb       Local parameter THESATB after clipping       V-1       none         1p_thesatg       Local parameter THESATG after clipping       V-1       none         1p_ax       Local parameter AX after clipping       none         1p_a1p       Local parameter ALP after clipping       V       none         1p_a1p1       Local parameter ALP1 after clipping       V       none         1p_a1p2       Local parameter ALP2 after clipping       V       none         1p_vp       Local parameter VP after clipping       V       none         1p_a1       Local parameter AL after clipping       V       none         1p_a2       Local parameter AL after clipping       V       none         1p_sta2       Local parameter STA2 after clipping       v       none         1p_a3       Local parameter STA2 after clipping       none       none         1p_a4       Local parameter A4 after clipping       I/sqrt(V)       none         1p_gco       Local parameter GCO after clipping       A       none         1p_igov       Local parameter IGOV after T-scaling and clipping       A       none         1p_igov       Local parameter IGOV after T-scaling and clipping       A       none         1p_scig       Local parameter STIG after cli   | lp_thesat   | Local parameter THESAT after T-scaling and clipping | $V^{-1}$         | none    |
| Ip_thesatg       Local parameter THESATG after clipping       V-1       none         lp_ax       Local parameter AX after clipping       none         lp_alp       Local parameter ALP after clipping       none         lp_alp1       Local parameter ALP1 after clipping       V       none         lp_alp2       Local parameter ALP2 after clipping       V-1       none         lp_vp       Local parameter VP after clipping       V       none         lp_a1       Local parameter A1 after clipping       v       none         lp_a2       Local parameter A2 after T-scaling and clipping       V       none         lp_sta2       Local parameter STA2 after clipping       none       none         lp_a3       Local parameter A3 after clipping       none       none         lp_a4       Local parameter A4 after clipping       l/sqrt(V)       none         lp_gco       Local parameter GCO after clipping       none         lp_iginv       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       none         lp_gc2       Local parameter STIG after clipping       none </td <td>lp_stthesat</td> <td>Local parameter STTHESAT after clipping</td> <td></td> <td>none</td>  | lp_stthesat | Local parameter STTHESAT after clipping             |                  | none    |
| 1p_ax       Local parameter AX after clipping       none         1p_a1p       Local parameter ALP after clipping       V       none         1p_a1p1       Local parameter ALP1 after clipping       V       none         1p_a1p2       Local parameter ALP2 after clipping       V       none         1p_vp       Local parameter VP after clipping       V       none         1p_a1       Local parameter A1 after clipping       V       none         1p_a2       Local parameter A2 after T-scaling and clipping       V       none         1p_a3       Local parameter STA2 after clipping       none       none         1p_a4       Local parameter A4 after clipping       I/sqrt(V)       none         1p_gco       Local parameter GCO after clipping       none       none         1p_iginv       Local parameter IGINV after T-scaling and clipping       A       none         1p_igov       Local parameter IGOVD after T-scaling and clipping       A       none         1p_stig       Local parameter STIG after clipping       none         1p_gc2       Local parameter GC2 after clipping       none         1p_gc3       Local parameter GC3 after clipping       v       none         1p_agid1       Local parameter AGIDL after clipping       A/V³   | lp_thesatb  | Local parameter THESATB after clipping              | $V^{-1}$         | none    |
| lp_alp       Local parameter ALP after clipping       none         lp_alp1       Local parameter ALP1 after clipping       V       none         lp_alp2       Local parameter ALP2 after clipping       V       none         lp_vp       Local parameter VP after clipping       V       none         lp_a1       Local parameter Al after clipping       V       none         lp_a2       Local parameter A2 after Clipping       V       none         lp_a5       Local parameter STA2 after clipping       none       none         lp_a3       Local parameter A3 after clipping       none       none         lp_a4       Local parameter A4 after clipping       lysqrt(V)       none         lp_gco       Local parameter GCO after clipping       A       none         lp_iginv       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igov       Local parameter GC2 after clipping       none       none         lp_stig       Local parameter STIG after clipping       none       none         lp_gc2       Local parameter GC2 after clipping       none       none         lp_gc3       Local parameter CHIB after clipping<   | lp_thesatg  | Local parameter THESATG after clipping              | $V^{-1}$         | none    |
| lp_alp1       Local parameter ALP1 after clipping       V       none         lp_alp2       Local parameter ALP2 after clipping       V-1       none         lp_vp       Local parameter VP after clipping       V       none         lp_a1       Local parameter AI after clipping       v       none         lp_a2       Local parameter A2 after T-scaling and clipping       V       none         lp_sta2       Local parameter STA2 after clipping       none       none         lp_a3       Local parameter A3 after clipping       none       none         lp_a4       Local parameter A4 after clipping       l/sqrt(V)       none         lp_gco       Local parameter GCO after clipping       none         lp_iginv       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igovd       Local parameter IGOVD after T-scaling and clipping       none         lp_stig       Local parameter STIG after clipping       none         lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       V       none         lp_chib       Local parameter AGIDL after clipping       A/V³ <td>lp_ax</td> <td>Local parameter AX after clipping</td> <td></td> <td>none</td>   | lp_ax       | Local parameter AX after clipping                   |                  | none    |
| lp_alp2       Local parameter ALP2 after clipping       V <sup>-1</sup> none         lp_vp       Local parameter VP after clipping       V       none         lp_al       Local parameter Al after clipping       v       none         lp_a2       Local parameter A2 after T-scaling and clipping       V       none         lp_sta2       Local parameter STA2 after clipping       none       I/sqrt(V)       none         lp_a3       Local parameter A3 after clipping       I/sqrt(V)       none         lp_a4       Local parameter GCO after clipping       none       I/sqrt(V)       none         lp_igoo       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         lp_stig       Local parameter STIG after clipping       none       none         lp_gc2       Local parameter GC2 after clipping       none       none         lp_gc3       Local parameter GC3 after clipping       V       none         lp_agidl       Local parameter AGIDL after clipping       A/V³       none   | lp_alp      | Local parameter ALP after clipping                  |                  | none    |
| lp_vp       Local parameter VP after clipping       V       none         lp_a1       Local parameter A1 after clipping       v       none         lp_a2       Local parameter A2 after T-scaling and clipping       V       none         lp_sta2       Local parameter STA2 after clipping       none       none         lp_a3       Local parameter A3 after clipping       none       1/sqrt(V)       none         lp_a4       Local parameter GCO after clipping       none       none         lp_igoo       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOVD after T-scaling and clipping       A       none         lp_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         lp_stig       Local parameter STIG after clipping       none       none         lp_gc2       Local parameter GC2 after clipping       none       none         lp_gc3       Local parameter GC3 after clipping       v       none         lp_agid1       Local parameter AGIDL after clipping       A/V³       none  | lp_alp1     | Local parameter ALP1 after clipping                 | V                | none    |
| 1p_a1       Local parameter A1 after clipping       none         1p_a2       Local parameter A2 after T-scaling and clipping       V       none         1p_sta2       Local parameter STA2 after clipping       none         1p_a3       Local parameter A3 after clipping       1/sqrt(V)       none         1p_a4       Local parameter A4 after clipping       1/sqrt(V)       none         1p_gco       Local parameter GCO after clipping       none       none         1p_iginv       Local parameter IGINV after T-scaling and clipping       A       none         1p_igov       Local parameter IGOVD after T-scaling and clipping       A       none         1p_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         1p_stig       Local parameter STIG after clipping       none       none         1p_stig       Local parameter GC2 after clipping       none       none         1p_stig       Local parameter GC3 after clipping       none       none         1p_gc3       Local parameter GC3 after clipping       V       none         1p_agid1       Local parameter AGIDL after clipping       A/V3       none  | lp_alp2     | Local parameter ALP2 after clipping                 | $V^{-1}$         | none    |
| lp_a2Local parameter A2 after T-scaling and clippingVnonelp_sta2Local parameter STA2 after clippingnonelp_a3Local parameter A3 after clippingnonelp_a4Local parameter A4 after clippingl/sqrt(V)nonelp_gcoLocal parameter GCO after clippingnonelp_iginvLocal parameter IGINV after T-scaling and clippingAnonelp_igovLocal parameter IGOV after T-scaling and clippingAnonelp_igovdLocal parameter IGOVD after T-scaling and clippingAnonelp_stigLocal parameter STIG after clippingnonenonelp_sc2Local parameter GC2 after clippingnonenonelp_gc3Local parameter GC3 after clippingnonenonelp_chibLocal parameter CHIB after clippingVnonelp_agidlLocal parameter AGIDL after clippingA/V³none   | lp_vp       | Local parameter VP after clipping                   | V                | none    |
| 1p_sta2       Local parameter STA2 after clipping       none         1p_a3       Local parameter A3 after clipping       none         1p_a4       Local parameter A4 after clipping       1/sqrt(V)       none         1p_gco       Local parameter GCO after clipping       none         1p_iginv       Local parameter IGINV after T-scaling and clipping       A       none         1p_igov       Local parameter IGOV after T-scaling and clipping       A       none         1p_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         1p_stig       Local parameter STIG after clipping       none         1p_gc2       Local parameter GC2 after clipping       none         1p_gc3       Local parameter GC3 after clipping       none         1p_chib       Local parameter CHIB after clipping       V       none         1p_agid1       Local parameter AGIDL after clipping       A/V3       none   | lp_a1       | Local parameter A1 after clipping                   |                  | none    |
| Local parameter A3 after clipping none  1p_a4 Local parameter A4 after clipping 1/sqrt(V) none  1p_gco Local parameter GCO after clipping none  1p_iginv Local parameter IGINV after T-scaling and clipping A none  1p_igov Local parameter IGOV after T-scaling and clipping A none  1p_igovd Local parameter IGOVD after T-scaling and clipping A none  1p_stig Local parameter STIG after clipping none  1p_gc2 Local parameter GC2 after clipping none  1p_gc3 Local parameter GC3 after clipping none  1p_chib Local parameter CHIB after clipping V none  1p_agid1 Local parameter AGIDL after clipping A/V³ none  | lp_a2       | Local parameter A2 after T-scaling and clipping     | V                | none    |
| lp_a4Local parameter A4 after clipping1/sqrt(V)nonelp_gcoLocal parameter GCO after clippingnonelp_iginvLocal parameter IGINV after T-scaling and clippingAnonelp_igovLocal parameter IGOV after T-scaling and clippingAnonelp_igovdLocal parameter IGOVD after T-scaling and clippingAnonelp_stigLocal parameter STIG after clippingnonelp_gc2Local parameter GC2 after clippingnonelp_gc3Local parameter GC3 after clippingnonelp_chibLocal parameter CHIB after clippingVnonelp_agidlLocal parameter AGIDL after clippingA/V³none  | lp_sta2     | Local parameter STA2 after clipping                 |                  | none    |
| lp_gco       Local parameter GCO after clipping       none         lp_iginv       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         lp_stig       Local parameter STIG after clipping       none         lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       none         lp_chib       Local parameter CHIB after clipping       V       none         lp_agid1       Local parameter AGIDL after clipping       A/V³       none  | lp_a3       | Local parameter A3 after clipping                   |                  | none    |
| lp_iginv       Local parameter IGINV after T-scaling and clipping       A       none         lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         lp_stig       Local parameter STIG after clipping       none         lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       none         lp_chib       Local parameter CHIB after clipping       V       none         lp_agidl       Local parameter AGIDL after clipping       A/V³       none   | lp_a4       | Local parameter A4 after clipping                   | 1/sqrt(V)        | none    |
| lp_igov       Local parameter IGOV after T-scaling and clipping       A       none         lp_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         lp_stig       Local parameter STIG after clipping       none         lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       none         lp_chib       Local parameter CHIB after clipping       V       none         lp_agidl       Local parameter AGIDL after clipping       A/V³       none  | lp_gco      | Local parameter GCO after clipping                  |                  | none    |
| lp_igovd       Local parameter IGOVD after T-scaling and clipping       A       none         lp_stig       Local parameter STIG after clipping       none         lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       none         lp_chib       Local parameter CHIB after clipping       V       none         lp_agidl       Local parameter AGIDL after clipping       A/V³       none   | lp_iginv    | Local parameter IGINV after T-scaling and clipping  | A                | none    |
| lp_stig       Local parameter STIG after clipping       none         lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       none         lp_chib       Local parameter CHIB after clipping       V       none         lp_agid1       Local parameter AGIDL after clipping       A/V³       none  | lp_igov     | Local parameter IGOV after T-scaling and clipping   | A                | none    |
| lp_gc2       Local parameter GC2 after clipping       none         lp_gc3       Local parameter GC3 after clipping       none         lp_chib       Local parameter CHIB after clipping       V       none         lp_agid1       Local parameter AGIDL after clipping       A/V³       none   | lp_igovd    | Local parameter IGOVD after T-scaling and clipping  | A                | none    |
| lp_gc3     Local parameter GC3 after clipping     none       lp_chib     Local parameter CHIB after clipping     V     none       lp_agidl     Local parameter AGIDL after clipping     A/V³     none  | lp_stig     | Local parameter STIG after clipping                 |                  | none    |
| lp_chib     Local parameter CHIB after clipping     V     none       lp_agidl     Local parameter AGIDL after clipping     A/V <sup>3</sup> none   | lp_gc2      | Local parameter GC2 after clipping                  |                  | none    |
| lp_agidl Local parameter AGIDL after clipping A/V <sup>3</sup> none  | lp_gc3      | Local parameter GC3 after clipping                  |                  | none    |
|  | lp_chib     | Local parameter CHIB after clipping                 | V                | none    |
|  | lp_agidl    | Local parameter AGIDL after clipping                | A/V <sup>3</sup> | none    |
|  |             | Local parameter AGIDLD after clipping               | A/V <sup>3</sup> | none    |

Table 2-120. MOSFET level 103 Output Variables

| Parameter    | Description   | Units                 | Default |
|--------------|---|-----------------------|---------|
| lp_bgidl     | Local parameter BGIDL after T-scaling and clipping    | V                     | none    |
| lp_bgidld    | Local parameter BGIDLD after T-scaling and clipping   | V                     | none    |
| lp_stbgidl   | Local parameter STBGIDL after clipping                | V/K                   | none    |
| lp_stbgidld  | Local parameter STBGIDLD after clipping               | V/K                   | none    |
| lp_cgidl     | Local parameter CGIDL after clipping                  |                       | none    |
| lp_cgidld    | Local parameter CGIDLD after clipping                 |                       | none    |
| lp_cox       | Local parameter COX after clipping                    | F                     | none    |
| lp_cgov      | Local parameter CGOV after clipping                   | F                     | none    |
| lp_cgovd     | Local parameter CGOVD after clipping                  | F                     | none    |
| lp_cgbov     | Local parameter CGBOV after clipping                  | F                     | none    |
| lp_cfr       | Local parameter CFR after clipping                    | F                     | none    |
| lp_cfrd      | Local parameter CFRD after clipping                   | F                     | none    |
| lp_fnt       | Local parameter FNT after clipping                    |                       | none    |
| lp_fntexc    | Local parameter FNTEXC after clipping                 |                       | none    |
| lp_nfa       | Local parameter NFA after clipping                    | 1/(V m <sup>4</sup> ) | none    |
| lp_nfb       | Local parameter NFB after clipping                    | 1/(V m <sup>4</sup> ) | none    |
| lp_nfc       | Local parameter NFC after clipping                    | $V^{-1}$              | none    |
| lp_ef        | Local parameter EF after clipping                     |                       | none    |
| lp_vfbedge   | Local parameter VFBEDGE after T-scaling and clipping  | V                     | none    |
| lp_stvfbedge | Local parameter STVFBEDGE after clipping              | V/K                   | none    |
| lp_dphibedge | Local parameter DPHIBEDGE after clipping              | V                     | none    |
| lp_neffedge  | Local parameter NEFFEDGE after clipping               | $m^{-3}$              | none    |
| lp_ctedge    | Local parameter CTEDGE after clipping                 |                       | none    |
| lp_betnedge  | Local parameter BETNEDGE after T-scaling and clipping | m <sup>2</sup> /(Vs)  | none    |
| lp_stbetedge | Local parameter STBETEDGE after clipping              |                       | none    |
| lp_psceedge  | Local parameter PSCEEDGE after clipping               |                       | none    |
| lp_pscebedge | Local parameter PSCEBEDGE after clipping              | $V^{-1}$              | none    |
| lp_pscededge | Local parameter PSCEDEDGE after clipping              | $V^{-1}$              | none    |
| lp_cfedge    | Local parameter CFEDGE after clipping                 | V                     | none    |
| lp_cfdedge   | Local parameter CFDEDGE after clipping                | $V^{-1}$              | none    |
| lp_cfbedge   | Local parameter CFBEDGE after clipping                | $V^{-1}$              | none    |
| lp_fntedge   | Local parameter FNTEDGE after clipping                |                       | none    |
| lp_nfaedge   | Local parameter NFAEDGE after clipping                | 1/(V m <sup>4</sup> ) | none    |
| lp_nfbedge   | Local parameter NFBEDGE after clipping                | 1/(V m <sup>4</sup> ) | none    |

Table 2-120. MOSFET level 103 Output Variables

| Parameter  | Description  | Units    | Default |
|------------|--|----------|---------|
| lp_nfcedge | Local parameter NFCEDGE after clipping   | $V^{-1}$ | none    |
| lp_efedge  | Local parameter EFEDGE after clipping  |          | none    |
| lp_rg      | Local parameter RG after clipping  | Ohm      | none    |
| lp_rse     | Local parameter RSE after clipping   | Ohm      | none    |
| lp_rde     | Local parameter RDE after clipping   | Ohm      | none    |
| lp_rbulk   | Local parameter RBULK after clipping   | Ohm      | none    |
| lp_rwell   | Local parameter RWELL after clipping   | Ohm      | none    |
| lp_rjuns   | Local parameter RJUNS after clipping   | Ohm      | none    |
| lp_rjund   | Local parameter RJUND after clipping   | Ohm      | none    |
| z k        | Device Temperature   | K        | none    |
| cjosbot    | Bottom component of total zero-bias source junction capacitance at device temperature    | F        | none    |
| cjossti    | STI-edge component of total zero-bias source junction capacitance at device temperature  | F        | none    |
| cjosgat    | Gate-edge component of total zero-bias source junction capacitance at device temperature | F        | none    |
| vbisbot    | Built-in voltage of source-side bottom junction at device temperature                    | V        | none    |
| vbissti    | Built-in voltage of source-side STI-edge junction at device temperature                  | V        | none    |
| vbisgat    | Built-in voltage of source-side gate-edge junction at device temperature                 | V        | none    |
| idsatsbot  | Total source-side bottom junction saturation current                                     | A        | none    |
| idsatssti  | Total source-side STI-edge junction saturation current                                   | A        | none    |
| idsatsgat  | Total source-side gate-edge junction saturation current                                  | A        | none    |
| cjosbotd   | Bottom component of total zero-bias drain junction capacitance at device temperature     | F        | none    |
| cjosstid   | STI-edge component of total zero-bias drain junction capacitance at device temperature   | F        | none    |
| cjosgatd   | Gate-edge component of total zero-bias drain junction capacitance at device temperature  | F        | none    |
| vbisbotd   | Built-in voltage of drain-side bottom junction at device temperature                     | V        | none    |
| vbisstid   | Built-in voltage of drain-side STI-edge junction at device temperature                   | V        | none    |
| vbisgatd   | Built-in voltage of drain-side gate-edge junction at device temperature                  | V        | none    |
| idsatsbotd | Total drain-side bottom junction saturation current                                      | A        | none    |
| idsatsstid | Total drain-side STI-edge junction saturation current                                    | A        | none    |

Table 2-120. MOSFET level 103 Output Variables

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| idsatsgatd | Total drain-side gate-edge junction saturation current | A     | none    |

Table 2-121. PSP103VA MOSFET with self-heating Device Instance Parameters

| Parameter  | Description   | Units          | Default |
|------------|---|----------------|---------|
| ABDRAIN    | Bottom area of drain junction   | $m^2$          | 1e-12   |
| ABSOURCE   | Bottom area of source junction  | m <sup>2</sup> | 1e-12   |
| AD         | Bottom area of drain junction   | m <sup>2</sup> | 1e-12   |
| AS         | Bottom area of source junction  | m <sup>2</sup> | 1e-12   |
| DELVTO     | Threshold voltage shift parameter                                       | V              | 0       |
| DELVTOEDGE | Threshold voltage shift parameter of edge transistor                    | V              | 0       |
| FACTUO     | Zero-field mobility pre-factor  | _              | 1       |
| FACTUOEDGE | Zero-field mobility pre-factor of edge transistor                       | _              | 1       |
| JW         | Gate-edge length of source/drain junction                               | m              | 1e-06   |
| L          | Design length   | m              | 1e-05   |
| LGDRAIN    | Gate-edge length of drain junction                                      | m              | 1e-06   |
| LGSOURCE   | Gate-edge length of source junction                                     | m              | 1e-06   |
| LSDRAIN    | STI-edge length of drain junction                                       | m              | 1e-06   |
| LSSOURCE   | STI-edge length of source junction                                      | m              | 1e-06   |
| M          | Alias for MULT  | _              | 1       |
| MULT       | Number of devices in parallel   | _              | 1       |
| NF         | Number of fingers   | _              | 1       |
| NGCON      | Number of gate contacts   | _              | 1       |
| NRD        | Number of squares of drain diffusion                                    | _              | 0       |
| NRS        | Number of squares of source diffusion                                   | _              | 0       |
| PD         | Perimeter of drain junction   | m              | 1e-06   |
| PS         | Perimeter of source junction  | m              | 1e-06   |
| SA         | Distance between OD-edge and poly from one side                         | m              | 0       |
| SB         | Distance between OD-edge and poly from other side                       | m              | 0       |
| SC         | Distance between OD-edge and nearest well edge                          | m              | 0       |
| SCA        | Integral of the first distribution function for scattered well dopants  | _              | 0       |
| SCB        | Integral of the second distribution function for scattered well dopants | _              | 0       |
| SCC        | Integral of the third distribution function for scattered well dopants  | _              | 0       |
| SD         | Distance between neighbouring fingers                                   | m              | 0       |

Table 2-121. PSP103VA MOSFET with self-heating Device Instance Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| W         | Design width                                       | m     | 1e-05   |
| XGW       | Distance from the gate contact to the channel edge | m     | 1e-07   |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter | Description   | Units            | Default |
|-----------|---|------------------|---------|
| A1        | Impact-ionization pre-factor                                |                  | 1       |
| A1L       | Length dependence of A1                                     | _                | 0       |
| A10       | Geometry independent impact-ionization pre-factor           | _                | 1       |
| A1W       | Width dependence of A1                                      | _                | 0       |
| A2        | Impact-ionization exponent at TR                            | V                | 10      |
| A20       | Impact-ionization exponent at TR                            | V                | 10      |
| A3        | Saturation-voltage dependence of impact-ionization          | _                | 1       |
| A3L       | Length dependence of A3                                     | _                | 0       |
| A30       | Geometry independent saturation-voltage dependence of II    | _                | 1       |
| A3W       | Width dependence of A3                                      | _                | 0       |
| A4        | Back-bias dependence of impact-ionization                   | $V^{-1/2}$       | 0       |
| A4L       | Length dependence of A4                                     |                  | 0       |
| A40       | Geometry independent back-bias dependence of II             | $V^{-1/2}$       | 0       |
| A4W       | Width dependence of A4                                      |                  | 0       |
| AGIDL     | GIDL pre-factor   | A/V <sup>3</sup> | 0       |
| AGIDLD    | GIDL pre-factor for drain side                              | A/V <sup>3</sup> | 0       |
| AGIDLDW   | Width dependence of GIDL pre-factor for drain side          | A/V <sup>3</sup> | 0       |
| AGIDLW    | Width dependence of GIDL pre-factor                         | A/V <sup>3</sup> | 0       |
| ALP       | CLM pre-factor  |                  | 0.01    |
| ALP1      | CLM enhancement factor above threshold                      | V                | 0       |
| ALP1L1    | Length dependence of CLM enhancement factor above threshold | V                | 0       |
| ALP1L2    | Second_order length dependence of ALP1                      |                  | 0       |
| ALP1LEXP  | Exponent for length dependence of ALP1                      |                  | 0.5     |
| ALP1W     | Width dependence of ALP1                                    | _                | 0       |
| ALP2      | CLM enhancement factor below threshold                      | $V^{-1}$         | 0       |
| ALP2L1    | Length dependence of CLM enhancement factor below threshold | $V^{-1}$         | 0       |
| ALP2L2    | Second_order length dependence of ALP2                      | _                | 0       |
| ALP2LEXP  | Exponent for length dependence of ALP2                      | _                | 0.5     |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter | Description  | Units                | Default |
|-----------|--|----------------------|---------|
| ALP2W     | Width dependence of ALP2   | _                    | 0       |
| ALPL      | Length dependence of ALP   | _                    | 0.0005  |
| ALPLEXP   | Exponent for length dependence of ALP  | _                    | 1       |
| ALPNOI    | Exponent for length offset for flicker noise                                     | _                    | 2       |
| ALPW      | Width dependence of ALP  | _                    | 0       |
| AX        | Linear/saturation transition factor  | _                    | 3       |
| AXL       | Length dependence of AX  | _                    | 0.4     |
| AXO       | Geometry independent linear/saturation transition factor                         | _                    | 18      |
| BETEDGEW  | Width scaling coefficient of edge transistor mobility                            | _                    | 0       |
| BETN      | Channel aspect ratio times zero-field mobility                                   | $m^2/(Vs)$           | 0.07    |
| BETNEDGE  | Channel aspect ratio times zero-field mobility of edge transistor                | m <sup>2</sup> /(Vs) | 0.0005  |
| BETW1     | First higher-order width scaling coefficient of BETN                             | _                    | 0       |
| BETW2     | Second higher-order width scaling coefficient of BETN                            | _                    | 0       |
| BGIDL     | GIDL probability factor at TR  | V                    | 41      |
| BGIDLD    | GIDL probability factor at TR for drain side                                     | V                    | 41      |
| BGIDLDO   | GIDL probability factor at TR for drain side                                     | V                    | 41      |
| BGIDLO    | GIDL probability factor at TR  | V                    | 41      |
| СВВТВОТ   | Band-to-band tunneling prefactor of bottom component for source-bulk junction    | A/V <sup>3</sup>     | 1e-12   |
| CBBTBOTD  | Band-to-band tunneling prefactor of bottom component for drain-bulk junction     | A/V <sup>3</sup>     | 1e-12   |
| CBBTGAT   | Band-to-band tunneling prefactor of gate-edge component for source-bulk junction | Am/V <sup>3</sup>    | 1e-18   |
| CBBTGATD  | Band-to-band tunneling prefactor of gate-edge component for drain-bulk junction  | Am/V <sup>3</sup>    | 1e-18   |
| CBBTSTI   | Band-to-band tunneling prefactor of STI-edge component for source-bulk junction  | Am/V <sup>3</sup>    | 1e-18   |
| CBBTSTID  | Band-to-band tunneling prefactor of STI-edge component for drain-bulk junction   | Am/V <sup>3</sup>    | 1e-18   |
| CF        | DIBL-parameter   | _                    | 0       |
| CFB       | Back bias dependence of CF   | $V^{-1}$             | 0       |
| CFBEDGE   | Bulk voltage dependence parameter of DIBL-parameter of edge transistors          | $V^{-1}$             | 0       |
| CFBEDGEO  | Bulk voltage dependence parameter of DIBL-parameter of edge transistors          | $V^{-1}$             | 0       |
|           |  | $V^{-1}$             |         |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter  | Description  | Units            | Default |
|------------|--|------------------|---------|
| CFD        | Drain voltage dependence of CF   | $V^{-1}$         | 0       |
| CFDEDGE    | Drain voltage dependence parameter of DIBL-parameter of edge transistors                 | $V^{-1}$         | 0       |
| CFDEDGEO   | Drain voltage dependence parameter of DIBL-parameter of edge transistors                 | $V^{-1}$         | 0       |
| CFDO       | Drain voltage dependence of CF   | $V^{-1}$         | 0       |
| CFEDGE     | DIBL parameter of edge transistors   | _                | 0       |
| CFEDGEL    | Length dependence of DIBL-parameter of edge transistors                                  | _                | 0       |
| CFEDGELEXP | Exponent for length dependence of DIBL-parameter of edge transistors                     | _                | 2       |
| CFEDGEW    | Width dependence of DIBL-parameter of edge transistors                                   | _                | 0       |
| CFL        | Length dependence of DIBL-parameter  | _                | 0       |
| CFLEXP     | Exponent for length dependence of CF   |                  | 2       |
| CFR        | Outer fringe capacitance   | F                | 0       |
| CFRD       | Outer fringe capacitance for drain side  | F                | 0       |
| CFRDW      | Outer fringe capacitance for 1 um wide channel for drain side                            | F                | 0       |
| CFRW       | Outer fringe capacitance for 1 um wide channel   | F                | 0       |
| CFW        | Width dependence of CF   | _                | 0       |
| CGBOV      | Oxide capacitance for gate-bulk overlap  | F                | 0       |
| CGBOVL     | Oxide capacitance for gate-bulk overlap for 1 um long channel                            | F                | 0       |
| CGIDL      | Back-bias dependence of GIDL   | _                | 0       |
| CGIDLD     | Back-bias dependence of GIDL for drain side  | _                | 0       |
| CGIDLDO    | Back-bias dependence of GIDL for drain side  |                  | 0       |
| CGIDLO     | Back-bias dependence of GIDL   | _                | 0       |
| CGOV       | Oxide capacitance for gate-drain/source overlap  | F                | 1e-15   |
| CGOVD      | Oxide capacitance for gate-drain overlap   | F                | 1e-15   |
| CHIB       | Tunnelling barrier height  | V                | 3.1     |
| CHIBO      | Tunnelling barrier height  | V                | 3.1     |
| CJORBOT    | Zero-bias capacitance per unit-of-area of bottom component for source-bulk junction      | F/m <sup>2</sup> | 0.001   |
| CJORBOTD   | Zero-bias capacitance per unit-of-area of bottom component for drain-bulk junction       | F/m <sup>2</sup> | 0.001   |
| CJORGAT    | Zero-bias capacitance per unit-of-length of gate-edge component for source-bulk junction | F/m              | 1e-09   |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter | Description   | Units            | Default |
|-----------|---|------------------|---------|
| CJORGATD  | Zero-bias capacitance per unit-of-length of gate-edge component for drain-bulk junction | F/m              | 1e-09   |
| CJORSTI   | Zero-bias capacitance per unit-of-length of STI-edge component for source-bulk junction | F/m              | 1e-09   |
| CJORSTID  | Zero-bias capacitance per unit-of-length of STI-edge component for drain-bulk junction  | F/m              | 1e-09   |
| COX       | Oxide capacitance for intrinsic channel   | F                | 1e-14   |
| CS        | Coulomb scattering parameter at TR  | _                | 0       |
| CSL       | Length dependence of CS   | _                | 0       |
| CSLEXP    | Exponent for length dependence of CS  | _                | 1       |
| CSLW      | Area dependence of CS   | _                | 0       |
| CSO       | Geometry independent coulomb scattering parameter at TR                                 | _                | 0       |
| CSRHBOT   | Shockley-Read-Hall prefactor of bottom component for source-bulk junction               | A/m <sup>3</sup> | 100     |
| CSRHBOTD  | Shockley-Read-Hall prefactor of bottom component for drain-bulk junction                | A/m <sup>3</sup> | 100     |
| CSRHGAT   | Shockley-Read-Hall prefactor of gate-edge component for source-bulk junction            | A/m <sup>2</sup> | 0.0001  |
| CSRHGATD  | Shockley-Read-Hall prefactor of gate-edge component for drain-bulk junction             | A/m <sup>2</sup> | 0.0001  |
| CSRHSTI   | Shockley-Read-Hall prefactor of STI-edge component for source-bulk junction             | A/m <sup>2</sup> | 0.0001  |
| CSRHSTID  | Shockley-Read-Hall prefactor of STI-edge component for drain-bulk junction              | A/m <sup>2</sup> | 0.0001  |
| CSW       | Width dependence of CS  | _                | 0       |
| T         | Interface states factor   | _                | 0       |
| CTATBOT   | Trap-assisted tunneling prefactor of bottom component for source-bulk junction          | A/m <sup>3</sup> | 100     |
| CTATBOTD  | Trap-assisted tunneling prefactor of bottom component for drain-bulk junction           | A/m <sup>3</sup> | 100     |
| CTATGAT   | Trap-assisted tunneling prefactor of gate-edge component for source-bulk junction       | A/m <sup>2</sup> | 0.0001  |
| CTATGATD  | Trap-assisted tunneling prefactor of gate-edge component for drain-bulk junction        | A/m <sup>2</sup> | 0.0001  |
| CTATSTI   | Trap-assisted tunneling prefactor of STI-edge component for source-bulk junction        | A/m <sup>2</sup> | 0.0001  |
| CTATSTID  | Trap-assisted tunneling prefactor of STI-edge component for drain-bulk junction         | A/m <sup>2</sup> | 0.0001  |
| CTEDGE    | Interface states factor of edge transistors   | _                | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter     | Description   | Units    | Default |
|---------------|---|----------|---------|
| CTEDGEL       | Length dependence of interface states factor of edge transistors              | _        | 0       |
| CTEDGELEXP    | Exponent for length dependence of interface states factor of edge transistors | _        | 1       |
| CTEDGEO       | Geometry-independent interface states factor of edge transistors              | _        | 0       |
| СТН           | Thermal capacitance   | _        | 0       |
| CTHLW         | Length-correction to width dependence of thermal capacitance                  | _        | 0       |
| СТНО          | Geometry independent part of thermal capacitance                              |          | 0       |
| CTHW1         | Width dependence of thermal capacitance                                       | _        | 0       |
| CTHW2         | Offset in width dependence of thermal capacitance                             | _        | 0       |
| CTL           | Length dependence of interface states factor                                  |          | 0       |
| CTLEXP        | Exponent for length dependence of interface states factor                     | _        | 1       |
| CTLW          | Area dependence of interface states factor                                    | _        | 0       |
| СТО           | Geometry-independent interface states factor                                  | _        | 0       |
| CTW           | Width dependence of interface states factor                                   | _        | 0       |
| DELVTAC       | Offset parameter for PHIB in separate charge calculation                      | V        | 0       |
| DELVTACL      | Length dependence of DELVTAC  | V        | 0       |
| DELVTACLEXP   | Exponent for length dependence of offset of DELVTAC                           | _        | 1       |
| DELVTACLW     | Area dependence of DELVTAC  | V        | 0       |
| DELVTACO      | Geom. independent offset parameter for PHIB in separate charge calculation    | V        | 0       |
| DELVTACW      | Width dependence of DELVTAC   | V        | 0       |
| DLQ           | Effective channel length reduction for CV                                     | m        | 0       |
| DLSIL         | Silicide extension over the physical gate length                              | m        | 0       |
| DNSUB         | Effective doping bias-dependence parameter                                    | $V^{-1}$ | 0       |
| DNSUBO        | Effective doping bias-dependence parameter                                    | $V^{-1}$ | 0       |
| DPHIB         | Offset parameter for PHIB   | V        | 0       |
| DPHIBEDGE     | Offset parameter for PHIB of edge transistors                                 | V        | 0       |
| DPHIBEDGEL    | Length dependence of edge transistor PHIB offset                              | V        | 0       |
| DPHIBEDGELEXP | Exponent for length dependence of edge transistor PHIB offset                 | _        | 1       |
| DPHIBEDGELW   | Area dependence of edge transistor PHIB offset                                | V        | 0       |
|               | Geometry independent of edge transistor PHIB offset                           | V        |         |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units              | Default |
|-------------|---|--------------------|---------|
| DPHIBEDGEW  | Width dependence of edge transistor PHIB offset   | V                  | 0       |
| OPHIBL      | Length dependence offset of PHIB  | V                  | 0       |
| DPHIBLEXP   | Exponent for length dependence of offset of PHIB  | _                  | 1       |
| OPHIBLW     | Area dependence of offset of PHIB   | V                  | 0       |
| OPHIBO      | Geometry independent offset of PHIB   | V                  | 0       |
| OPHIBW      | Width dependence of offset of PHIB  | V                  | 0       |
| DTA         | Temperature offset w.r.t. ambient temperature   | K                  | 0       |
| DVSBNUD     | Vsb-range for NUD-effect  | V                  | 1       |
| OVSBNUDO    | Vsb range for NUD-effect  | V                  | 1       |
| DWQ         | Effective channel width reduction for CV  | m                  | 0       |
| ΣF          | Flicker noise frequency exponent  | _                  | 1       |
| EFEDGE      | Flicker noise frequency exponent of edge transistors  | _                  | 1       |
| EFEDGEO     | Flicker noise frequency exponent  | _                  | 1       |
| EFO         | Flicker noise frequency exponent  | _                  | 1       |
| EPSROX      | Relative permittivity of gate dielectric  | _                  | 3.9     |
| EPSROXO     | Relative permittivity of gate dielectric  | _                  | 3.9     |
| FACNEFFAC   | Pre-factor for effective substrate doping in separate charge calculation  | _                  | 1       |
| FACNEFFACL  | Length dependence of FACNEFFAC  | _                  | 0       |
| FACNEFFACLW | Area dependence of FACNEFFAC  | _                  | 0       |
| FACNEFFACO  | Geom. independent pre-factor for effective substrate doping in separate charge calculation  | _                  | 1       |
| FACNEFFACW  | Width dependence of FACNEFFAC   | _                  | 0       |
| FBBTRBOT    | Normalization field at the reference temperature for band-to-band tunneling of bottom component for source-bulk junction          | Vm <sup>-1</sup>   | 1e+09   |
| FBBTRBOTD   | Normalization field at the reference temperature for band-to-band tunneling of bottom component for drain-bulk junction           | Vm <sup>-1</sup>   | 1e+09   |
| FBBTRGAT    | Normalization field at the reference temperature for<br>band-to-band tunneling of gate-edge component for<br>source-bulk junction | $\mathrm{Vm^{-1}}$ | 1e+09   |
| FBBTRGATD   | Normalization field at the reference temperature for<br>band-to-band tunneling of gate-edge component for<br>drain-bulk junction  | $ m Vm^{-1}$       | 1e+09   |
| FBBTRSTI    | Normalization field at the reference temperature for band-to-band tunneling of STI-edge component for source-bulk junction        | $\mathrm{Vm^{-1}}$ | 1e+09   |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units            | Default |
|-------------|---|------------------|---------|
| FBBTRSTID   | Normalization field at the reference temperature for<br>band-to-band tunneling of STI-edge component for<br>drain-bulk junction | Vm <sup>-1</sup> | 1e+09   |
| FBET1       | Relative mobility decrease due to first lateral profile   |                  | 0       |
| FBET1W      | Width dependence of relative mobility decrease due to first lateral profile   | _                | 0       |
| FBET2       | Relative mobility decrease due to second lateral profile  | _                | 0       |
| FBETEDGE    | Length dependence of edge transistor mobility   | _                | 0       |
| FETA        | Effective field parameter   | _                | 1       |
| FETAO       | Effective field parameter   | _                | 1       |
| FJUNQ       | Fraction below which source-bulk junction capacitance components are considered negligible                                      | _                | 0.03    |
| FJUNQD      | Fraction below which drain-bulk junction capacitance components are considered negligible                                       | _                | 0.03    |
| FNT         | Thermal noise coefficient   | _                | 1       |
| FNTEDGE     | Thermal noise coefficient of edge transistors   | _                | 1       |
| FNTEDGEO    | Thermal noise coefficient   | _                | 1       |
| FNTEXC      | Excess noise coefficient  | _                | 0       |
| FNTEXCL     | Length dependence coefficient of excess noise   | _                | 0       |
| FNTO        | Thermal noise coefficient   | _                | 1       |
| FOL1        | First length dependence coefficient for short channel body effect   | _                | 0       |
| FOL2        | Second length dependence coefficient for short channel body effect  | _                | 0       |
| FREV        | Coefficient for reverse breakdown current limitation  | _                | 1000    |
| GC2         | Gate current slope factor   | _                | 0.375   |
| GC20        | Gate current slope factor   | _                | 0.375   |
| GC3         | Gate current curvature factor   | _                | 0.063   |
| GC30        | Gate current curvature factor   | _                | 0.063   |
| GCO         | Gate tunnelling energy adjustment   | _                | 0       |
| GCOO        | Gate tunnelling energy adjustment   | _                | 0       |
| GFACNUD     | Body-factor change due to NUD-effect  |                  | 1       |
| GFACNUDL    | Length dependence of GFACNUD  | _                | 0       |
| GFACNUDLEXP | Exponent for length dependence of GFACNUD   | _                | 1       |
| GFACNUDLW   | Area dependence of GFACNUD  | _                | 0       |
| GFACNUDO    | Geom. independent body-factor change due to NUD-effect  | _                | 1       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter  | Description   | Units            | Default |
|------------|---|------------------|---------|
| GFACNUDW   | Width dependence of GFACNUD   |                  | 0       |
| IDSATRBOT  | Saturation current density at the reference temperature of bottom component for source-bulk junction    | A/m <sup>2</sup> | 1e-12   |
| IDSATRBOTD | Saturation current density at the reference temperature of bottom component for drain-bulk junction     | A/m <sup>2</sup> | 1e-12   |
| IDSATRGAT  | Saturation current density at the reference temperature of gate-edge component for source-bulk junction | A/m              | 1e-18   |
| IDSATRGATD | Saturation current density at the reference temperature of gate-edge component for drain-bulk junction  | A/m              | 1e-18   |
| IDSATRSTI  | Saturation current density at the reference temperature of STI-edge component for source-bulk junction  | A/m              | 1e-18   |
| IDSATRSTID | Saturation current density at the reference temperature of STI-edge component for drain-bulk junction   | A/m              | 1e-18   |
| IGINV      | Gate channel current pre-factor   | A                | 0       |
| IGINVLW    | Gate channel current pre-factor for 1 um**2 channel area  | A                | 0       |
| IGOV       | Gate overlap current pre-factor   | A                | 0       |
| IGOVD      | Gate overlap current pre-factor for drain side  | A                | 0       |
| IGOVDW     | Gate overlap current pre-factor for 1 um wide channel for drain side                                    | A                | 0       |
| IGOVW      | Gate overlap current pre-factor for 1 um wide channel   | A                | 0       |
| IMAX       | Maximum current up to which forward current behaves exponentially                                       | A                | 1000    |
| KUO        | Mobility degradation/enhancement coefficient  | m                | 0       |
| KUOWEL     | Length dependent mobility degradation factor  | _                | 0       |
| KUOWELW    | Area dependent mobility degradation factor  | _                | 0       |
| KUOWEO     | Geometrical independent mobility degradation factor   |                  | 0       |
| KUOWEW     | Width dependent mobility degradation factor   |                  | 0       |
| KVSAT      | Saturation velocity degradation/enhancement coefficient   | m                | 0       |
| KVTHO      | Threshold shift parameter   | Vm               | 0       |
| KVTHOWEL   | Length dependent threshold shift parameter  |                  | 0       |
| KVTHOWELW  | Area dependent threshold shift parameter  |                  | 0       |
| KVTHOWEO   | Geometrical independent threshold shift parameter   | _                | 0       |
| KVTHOWEW   | Width dependent threshold shift parameter   |                  | 0       |
| LAP        | Effective channel length reduction per side   | m                | 0       |
| LEVEL      | Model level   |                  | 103     |
|            |   |                  | 0       |
| LINTNOI    | Length offset for flicker noise   | m                | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| LKVTHO      | Length dependence of KVTHO  |       | 0       |
| LLODKUO     | Length parameter for UO stress effect   | _     | 0       |
| LLODVTH     | Length parameter for VTH-stress effect  | _     | 0       |
| LMAX        | Dummy parameter to label binning set  | m     | 1       |
| LMIN        | Dummy parameter to label binning set  | m     | 0       |
| LODETAO     | Eta0 shift modification factor for stress effect  | _     | 1       |
| LOV         | Overlap length for gate/drain and gate/source overlap capacitance   | m     | 0       |
| LOVD        | Overlap length for gate/drain overlap capacitance   | m     | 0       |
| LP1         | Mobility-related characteristic length of first lateral profile   | m     | 1e-08   |
| LP1W        | Width dependence of mobility-related characteristic length of first lateral profile                         | _     | 0       |
| LP2         | Mobility-related characteristic length of second lateral profile  | m     | 1e-08   |
| LPCK        | Char. length of lateral doping profile  | m     | 1e-08   |
| LPCKW       | Width dependence of char. length of lateral doping profile  | _     | 0       |
| LPEDGE      | Exponent for length dependence of edge transistor mobility  | m     | 1e-08   |
| LVARL       | Length dependence of LVAR   | _     | 0       |
| LVARO       | Geom. independent difference between actual and programmed gate length                                      | m     | 0       |
| LVARW       | Width dependence of LVAR  | _     | 0       |
| MEFFTATBOT  | Effective mass (in units of m0) for trap-assisted tunneling of bottom component for source-bulk junction    | _     | 0.25    |
| MEFFTATBOTD | Effective mass (in units of m0) for trap-assisted tunneling of bottom component for drain-bulk junction     |       | 0.25    |
| MEFFTATGAT  | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component for source-bulk junction | _     | 0.25    |
| MEFFTATGATD | Effective mass (in units of m0) for trap-assisted tunneling of gate-edge component for drain-bulk junction  | _     | 0.25    |
| MEFFTATSTI  | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component for source-bulk junction  | _     | 0.25    |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units             | Default |
|-------------|---|-------------------|---------|
| MEFFTATSTID | Effective mass (in units of m0) for trap-assisted tunneling of STI-edge component for drain-bulk junction | _                 | 0.25    |
| MUE         | Mobility reduction coefficient at TR  | m/V               | 0.5     |
| MUEO        | Geometry independent mobility reduction coefficient at TR   | m/V               | 0.5     |
| MUEW        | Width dependence of mobility reduction coefficient at TR  | _                 | 0       |
| NEFF        | Effective substrate doping  | $\mathrm{m}^{-3}$ | 5e+23   |
| NEFFEDGE    | Effective substrate doping of edge transistors  | $\mathrm{m}^{-3}$ | 5e+23   |
| NFA         | First coefficient of flicker noise  | _                 | 8e+22   |
| NFAEDGE     | First coefficient of flicker noise of edge transistors  | _                 | 8e+22   |
| NFAEDGELW   | First coefficient of flicker noise for 1 um**2 channel area   | _                 | 8e+22   |
| NFALW       | First coefficient of flicker noise for 1 um**2 channel area   | _                 | 8e+22   |
| NFB         | Second coefficient of flicker noise   | _                 | 3e+07   |
| NFBEDGE     | Second coefficient of flicker noise of edge transistors   | _                 | 3e+07   |
| NFBEDGELW   | Second coefficient of flicker noise for 1 um**2 channel area  | _                 | 3e+07   |
| NFBLW       | Second coefficient of flicker noise for 1 um**2 channel area  | _                 | 3e+07   |
| NFC         | Third coefficient of flicker noise  | $V^{-1}$          | 0       |
| NFCEDGE     | Third coefficient of flicker noise of edge transistors  | $V^{-1}$          | 0       |
| NFCEDGELW   | Third coefficient of flicker noise for 1 um**2 channel area   | $V^{-1}$          | 0       |
| NFCLW       | Third coefficient of flicker noise for 1 um**2 channel area   | $V^{-1}$          | 0       |
| NOV         | Effective doping of overlap region  | $\mathrm{m}^{-3}$ | 5e+25   |
| NOVD        | Effective doping of overlap region for drain side   | $m^{-3}$          | 5e+25   |
| NOVDO       | Effective doping of overlap region for drain side   | $\mathrm{m}^{-3}$ | 5e+25   |
| NOVO        | Effective doping of overlap region  | $\mathrm{m}^{-3}$ | 5e+25   |
| NP          | Gate poly-silicon doping  | $\mathrm{m}^{-3}$ | 1e+26   |
| NPCK        | Pocket doping level   | $m^{-3}$          | 1e+24   |
| NPCKW       | Width dependence of pocket doping NPCK due to segregation   | _                 | 0       |
| NPL         | Length dependence of gate poly-silicon doping   | _                 | 0       |
| NPO         | Geometry-independent gate poly-silicon doping   | $\mathrm{m}^{-3}$ | 1e+26   |
| NSLP        | Effective doping bias-dependence parameter  | V                 | 0.05    |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter  | Description  | Units             | Default |
|------------|--|-------------------|---------|
| NSLPO      | Effective doping bias-dependence parameter                                       | V                 | 0.05    |
| NSUBEDGEL  | Length dependence of edge transistor substrate doping                            | _                 | 0       |
| NSUBEDGELW | Area dependence of edge transistor substrate doping                              | _                 | 0       |
| NSUBEDGEO  | Geometry independent substrate doping of edge transistors                        | $\mathrm{m}^{-3}$ | 5e+23   |
| NSUBEDGEW  | Width dependence of edge transistor substrate doping                             | _                 | 0       |
| NSUBO      | Geometry independent substrate doping  | $\mathrm{m}^{-3}$ | 3e+23   |
| NSUBW      | Width dependence of background doping NSUBO due to segregation                   | _                 | 0       |
| PBOT       | Grading coefficient of bottom component for source-bulk junction                 | _                 | 0.5     |
| PBOTD      | Grading coefficient of bottom component for drain-bulk junction                  | _                 | 0.5     |
| PBRBOT     | Breakdown onset tuning parameter of bottom component for source-bulk junction    | V                 | 4       |
| PBRBOTD    | Breakdown onset tuning parameter of bottom component for drain-bulk junction     | V                 | 4       |
| PBRGAT     | Breakdown onset tuning parameter of gate-edge component for source-bulk junction | V                 | 4       |
| PBRGATD    | Breakdown onset tuning parameter of gate-edge component for drain-bulk junction  | V                 | 4       |
| PBRSTI     | Breakdown onset tuning parameter of STI-edge component for source-bulk junction  | V                 | 4       |
| PBRSTID    | Breakdown onset tuning parameter of STI-edge component for drain-bulk junction   | V                 | 4       |
| PGAT       | Grading coefficient of gate-edge component for source-bulk junction              | _                 | 0.5     |
| PGATD      | Grading coefficient of gate-edge component for drain-bulk junction               |                   | 0.5     |
| PHIGBOT    | Zero-temperature bandgap voltage of bottom component for source-bulk junction    | V                 | 1.16    |
| PHIGBOTD   | Zero-temperature bandgap voltage of bottom component for drain-bulk junction     | V                 | 1.16    |
| PHIGGAT    | Zero-temperature bandgap voltage of gate-edge component for source-bulk junction | V                 | 1.16    |
| PHIGGATD   | Zero-temperature bandgap voltage of gate-edge component for drain-bulk junction  | V                 | 1.16    |
| PHIGSTI    | Zero-temperature bandgap voltage of STI-edge component for source-bulk junction  | V                 | 1.16    |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units                | Default |
|-------------|--|----------------------|---------|
| PHIGSTID    | Zero-temperature bandgap voltage of STI-edge component for drain-bulk junction | V                    | 1.16    |
| PKUO        | Cross-term dependence of KUO   | _                    | 0       |
| PKVTHO      | Cross-term dependence of KVTHO   | _                    | 0       |
| PLA1        | Coefficient for the length dependence of A1                                    | _                    | 0       |
| PLA3        | Coefficient for the length dependence of A3                                    | _                    | 0       |
| PLA4        | Coefficient for the length dependence of A4                                    | $V^{-1/2}$           | 0       |
| PLAGIDL     | Coefficient for the length dependence of AGIDL                                 | A/V <sup>3</sup>     | 0       |
| PLAGIDLD    | Coefficient for the length dependence of AGIDL for drain side                  | A/V <sup>3</sup>     | 0       |
| PLALP       | Coefficient for the length dependence of ALP                                   | _                    | 0       |
| PLALP1      | Coefficient for the length dependence of ALP1                                  | V                    | 0       |
| PLALP2      | Coefficient for the length dependence of ALP2                                  | $V^{-1}$             | 0       |
| PLAX        | Coefficient for the length dependence of AX                                    | _                    | 0       |
| PLBETN      | Coefficient for the length dependence of BETN                                  | m <sup>2</sup> /(Vs) | 0       |
| PLBETNEDGE  | Coefficient for the length dependence of BETNEDGE                              | m <sup>2</sup> /(Vs) | 0       |
| PLCF        | Coefficient for the length dependence of CF                                    | _                    | 0       |
| PLCFEDGE    | Coefficient for the length dependence of CFEDGE                                | _                    | 0       |
| PLCFR       | Coefficient for the length dependence of CFR                                   | F                    | 0       |
| PLCFRD      | Coefficient for the length dependence of CFR for drain side                    | F                    | 0       |
| PLCGBOV     | Coefficient for the length dependence of CGBOV                                 | F                    | 0       |
| PLCGOV      | Coefficient for the length dependence of CGOV                                  | F                    | 0       |
| PLCGOVD     | Coefficient for the length dependence of CGOV for drain side                   | F                    | 0       |
| PLCOX       | Coefficient for the length dependence of COX                                   | F                    | 0       |
| PLCS        | Coefficient for the length dependence of CS                                    | _                    | 0       |
| PLCT        | Coefficient for the length dependence of CT                                    | _                    | 0       |
| PLCTEDGE    | Coefficient for the length dependence of CTEDGE                                | _                    | 0       |
| PLDELVTAC   | Coefficient for the length dependence of DELVTAC                               | V                    | 0       |
| PLDPHIB     | Coefficient for the length dependence of DPHIB                                 | V                    | 0       |
| PLDPHIBEDGE | Coefficient for the length dependence of DPHIBEDGE                             | V                    | 0       |
| PLFACNEFFAC | Coefficient for the length dependence of FACNEFFAC                             | _                    | 0       |
| PLFNTEXC    | Coefficient for the length dependence of FNTEXC                                | _                    | 0       |
| PLGFACNUD   | Coefficient for the length dependence of GFACNUD                               | _                    | 0       |
| PLIGINV     | Coefficient for the length dependence of IGINV                                 | A                    | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units             | Default |
|-------------|--|-------------------|---------|
| PLIGOV      | Coefficient for the length dependence of IGOV                | A                 | 0       |
| PLIGOVD     | Coefficient for the length dependence of IGOV for drain side | A                 | 0       |
| PLKUOWE     | Coefficient for the length dependence part of KUOWE          | _                 | 0       |
| PLKVTHOWE   | Coefficient for the length dependence part of KVTHOWE        | _                 | 0       |
| PLMUE       | Coefficient for the length dependence of MUE                 | m/V               | 0       |
| PLNEFF      | Coefficient for the length dependence of NEFF                | $\mathrm{m}^{-3}$ | 0       |
| PLNEFFEDGE  | Coefficient for the length dependence of NEFFEDGE            | $\mathrm{m}^{-3}$ | 0       |
| PLNFA       | Coefficient for the length dependence of NFA                 | _                 | 0       |
| PLNFAEDGE   | Coefficient for the length dependence of NFAEDGE             | _                 | 0       |
| PLNFB       | Coefficient for the length dependence of NFB                 | _                 | 0       |
| PLNFBEDGE   | Coefficient for the length dependence of NFBEDGE             | _                 | 0       |
| PLNFC       | Coefficient for the length dependence of NFC                 | $V^{-1}$          | 0       |
| PLNFCEDGE   | Coefficient for the length dependence of NFCEDGE             | $V^{-1}$          | 0       |
| PLNOV       | Coefficient for the length dependence of NOV                 | $\mathrm{m}^{-3}$ | 0       |
| PLNOVD      | Coefficient for the length dependence of NOV for drain side  | $m^{-3}$          | 0       |
| PLNP        | Coefficient for the length dependence of NP                  | $\mathrm{m}^{-3}$ | 0       |
| PLPSCE      | Coefficient for the length dependence of PSCE                | _                 | 0       |
| PLPSCEEDGE  | Coefficient for the length dependence of PSCEEDGE            | _                 | 0       |
| PLRS        | Coefficient for the length dependence of RS                  | Ω                 | 0       |
| PLSTBET     | Coefficient for the length dependence of STBET               | _                 | 0       |
| PLSTBETEDGE | Coefficient for the length dependence of STBETEDGE           | _                 | 0       |
| PLSTTHESAT  | Coefficient for the length dependence of STTHESAT            | _                 | 0       |
| PLSTVFB     | Coefficient for the length dependence of STVFB               | V/K               | 0       |
| PLSTVFBEDGE | Coefficient for the length dependence of STVFBEDGE           | V/K               | 0       |
| PLTHESAT    | Coefficient for the length dependence of THESAT              | $V^{-1}$          | 0       |
| PLTHESATB   | Coefficient for the length dependence of THESATB             | $V^{-1}$          | 0       |
| PLTHESATG   | Coefficient for the length dependence of THESATG             | $V^{-1}$          | 0       |
| PLVFB       | Coefficient for the length dependence of VFB                 | V                 | 0       |
| PLWA1       | Coefficient for the length times width dependence of A1      | _                 | 0       |
| PLWA3       | Coefficient for the length times width dependence of A3      | _                 | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units                | Default |
|-------------|---|----------------------|---------|
| PLWA4       | Coefficient for the length times width dependence of A4                   | $V^{-1/2}$           | 0       |
| PLWAGIDL    | Coefficient for the length times width dependence of AGIDL                | A/V <sup>3</sup>     | 0       |
| PLWAGIDLD   | Coefficient for the length times width dependence of AGIDL for drain side | A/V <sup>3</sup>     | 0       |
| PLWALP      | Coefficient for the length times width dependence of ALP                  |                      | 0       |
| PLWALP1     | Coefficient for the length times width dependence of ALP1                 | V                    | 0       |
| PLWALP2     | Coefficient for the length times width dependence of ALP2                 | $V^{-1}$             | 0       |
| PLWAX       | Coefficient for the length times width dependence of AX                   |                      | 0       |
| PLWBETN     | Coefficient for the length times width dependence of BETN                 | m <sup>2</sup> /(Vs) | 0       |
| PLWBETNEDGE | Coefficient for the length times width dependence of BETNEDGE             | m <sup>2</sup> /(Vs) | 0       |
| PLWCF       | Coefficient for the length times width dependence of CF                   | _                    | 0       |
| PLWCFEDGE   | Coefficient for the length times width dependence of CFEDGE               | _                    | 0       |
| PLWCFR      | Coefficient for the length times width dependence of CFR                  | F                    | 0       |
| PLWCFRD     | Coefficient for the length times width dependence of CFR for drain side   | F                    | 0       |
| PLWCGBOV    | Coefficient for the length times width dependence of CGBOV                | F                    | 0       |
| PLWCGOV     | Coefficient for the length times width dependence of CGOV                 | F                    | 0       |
| PLWCGOVD    | Coefficient for the length times width dependence of CGOV for drain side  | F                    | 0       |
| PLWCOX      | Coefficient for the length times width dependence of COX                  | F                    | 0       |
| PLWCS       | Coefficient for the length times width dependence of CS                   | _                    | 0       |
| PLWCT       | Coefficient for the length times width dependence of CT                   |                      | 0       |
| PLWCTEDGE   | Coefficient for the length times width dependence of CTEDGE               | _                    | 0       |
| PLWDELVTAC  | Coefficient for the length times width dependence of DELVTAC              | V                    | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter    | Description  | Units             | Default |
|--------------|--|-------------------|---------|
| PLWDPHIB     | Coefficient for the length times width dependence of DPHIB               | V                 | 0       |
| PLWDPHIBEDGE | Coefficient for the length times width dependence of DPHIBEDGE           | V                 | 0       |
| PLWFACNEFFAC | Coefficient for the length times width dependence of FACNEFFAC           | _                 | 0       |
| PLWFNTEXC    | Coefficient for the length times width dependence of FNTEXC              | _                 | 0       |
| PLWGFACNUD   | Coefficient for the length times width dependence of GFACNUD             | _                 | 0       |
| PLWIGINV     | Coefficient for the length times width dependence of IGINV               | A                 | 0       |
| PLWIGOV      | Coefficient for the length times width dependence of IGOV                | A                 | 0       |
| PLWIGOVD     | Coefficient for the length times width dependence of IGOV for drain side | A                 | 0       |
| PLWKUOWE     | Coefficient for the length times width dependence part of KUOWE          |                   | 0       |
| PLWKVTHOWE   | Coefficient for the length times width dependence part of KVTHOWE        | _                 | 0       |
| PLWMUE       | Coefficient for the length times width dependence of MUE                 | m/V               | 0       |
| PLWNEFF      | Coefficient for the length times width dependence of NEFF                | ${\rm m}^{-3}$    | 0       |
| PLWNEFFEDGE  | Coefficient for the length times width dependence of NEFFEDGE            | $m^{-3}$          | 0       |
| PLWNFA       | Coefficient for the length times width dependence of NFA                 |                   | 0       |
| PLWNFAEDGE   | Coefficient for the length times width dependence of NFAEDGE             |                   | 0       |
| PLWNFB       | Coefficient for the length times width dependence of NFB                 | _                 | 0       |
| PLWNFBEDGE   | Coefficient for the length times width dependence of NFBEDGE             | _                 | 0       |
| PLWNFC       | Coefficient for the length times width dependence of NFC                 | $V^{-1}$          | 0       |
| PLWNFCEDGE   | Coefficient for the length times width dependence of NFCEDGE             | $V^{-1}$          | 0       |
| PLWNOV       | Coefficient for the length times width dependence of NOV                 | $m^{-3}$          | 0       |
| PLWNOVD      | Coefficient for the length times width dependence of NOV for drain side  | $\mathrm{m}^{-3}$ | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter    | Description   | Units             | Default |
|--------------|---|-------------------|---------|
| PLWNP        | Coefficient for the length times width dependence of NP               | $\mathrm{m}^{-3}$ | 0       |
| PLWPSCE      | Coefficient for the length times width dependence of PSCE             | _                 | 0       |
| PLWPSCEEDGE  | Coefficient for the length times width dependence of PSCEEDGE         | _                 | 0       |
| PLWRS        | Coefficient for the length times width dependence of RS               | Ω                 | 0       |
| PLWSTBET     | Coefficient for the length times width dependence of STBET            | _                 | 0       |
| PLWSTBETEDGE | Coefficient for the length times width dependence of STBETEDGE        | _                 | 0       |
| PLWSTTHESAT  | Coefficient for the length times width dependence of STTHESAT         |                   | 0       |
| PLWSTVFB     | Coefficient for the length times width dependence of STVFB            | V/K               | 0       |
| PLWSTVFBEDGE | Coefficient for the length times width dependence of STVFBEDGE        | V/K               | 0       |
| PLWTHESAT    | Coefficient for the length times width dependence of THESAT           | $V^{-1}$          | 0       |
| PLWTHESATB   | Coefficient for the length times width dependence of THESATB          | $V^{-1}$          | 0       |
| PLWTHESATG   | Coefficient for the length times width dependence of THESATG          | $V^{-1}$          | 0       |
| PLWVFB       | Coefficient for the length times width dependence of VFB              | V                 | 0       |
| PLWXCOR      | Coefficient for the length times width dependence of XCOR             | $V^{-1}$          | 0       |
| PLXCOR       | Coefficient for the length dependence of XCOR                         | $V^{-1}$          | 0       |
| POA1         | Coefficient for the geometry independent part of A1                   |                   | 1       |
| POA2         | Coefficient for the geometry independent part of A2                   | V                 | 10      |
| POA3         | Coefficient for the geometry independent part of A3                   |                   | 1       |
| POA4         | Coefficient for the geometry independent part of A4                   | $V^{-1/2}$        | 0       |
| POAGIDL      | Coefficient for the geometry independent part of AGIDL                | A/V <sup>3</sup>  | 0       |
| POAGIDLD     | Coefficient for the geometry independent part of AGIDL for drain side | A/V <sup>3</sup>  | 0       |
| POALP        | Coefficient for the geometry independent part of ALP                  | _                 | 0.01    |
| POALP1       | Coefficient for the geometry independent part of ALP1                 | V                 | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter  | Description   | Units                | Default |
|------------|---|----------------------|---------|
| POALP2     | Coefficient for the geometry independent part of ALP2                 | $V^{-1}$             | 0       |
| POAX       | Coefficient for the geometry independent part of AX                   | _                    | 3       |
| POBETN     | Coefficient for the geometry independent part of BETN                 | m <sup>2</sup> /(Vs) | 0.07    |
| POBETNEDGE | Coefficient for the geometry independent part of BETNEDGE             | m <sup>2</sup> /(Vs) | 0.0005  |
| POBGIDL    | Coefficient for the geometry independent part of BGIDL                | V                    | 41      |
| POBGIDLD   | Coefficient for the geometry independent part of BGIDL for drain side | V                    | 41      |
| POCF       | Coefficient for the geometry independent part of CF                   | _                    | 0       |
| POCFB      | Coefficient for the geometry independent part of CFB                  | $V^{-1}$             | 0       |
| POCFBEDGE  | Coefficient for the geometry independent part of CFBEDGE              | $V^{-1}$             | 0       |
| POCFD      | Coefficient for the geometry independent part of CFD                  | $V^{-1}$             | 0       |
| POCFDEDGE  | Coefficient for the geometry independent part of CFDEDGE              | $V^{-1}$             | 0       |
| POCFEDGE   | Coefficient for the geometry independent part of CFEDGE               | _                    | 0       |
| POCFR      | Coefficient for the geometry independent part of CFR                  | F                    | 0       |
| POCFRD     | Coefficient for the geometry independent part of CFR for drain side   | F                    | 0       |
| POCGBOV    | Coefficient for the geometry independent part of CGBOV                | F                    | 0       |
| POCGIDL    | Coefficient for the geometry independent part of CGIDL                | _                    | 0       |
| POCGIDLD   | Coefficient for the geometry independent part of CGIDL for drain side | _                    | 0       |
| POCGOV     | Coefficient for the geometry independent part of CGOV                 | F                    | 1e-15   |
| POCGOVD    | Coefficient for the geometry independent part of CGOV for drain side  | F                    | 1e-15   |
| POCHIB     | Coefficient for the geometry independent part of CHIB                 | V                    | 3.1     |
| POCOX      | Coefficient for the geometry independent part of COX                  | F                    | 1e-14   |
| POCS       | Coefficient for the geometry independent part of CS                   |                      | 0       |
| POCT       | Coefficient for the geometry independent part of CT                   | _                    | 0       |
| POCTEDGE   | Coefficient for the geometry independent part of CTEDGE               | _                    | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units    | Default |
|-------------|--|----------|---------|
| PODELVTAC   | Coefficient for the geometry independent part of DELVTAC             | V        | 0       |
| PODNSUB     | Coefficient for the geometry independent part of DNSUB               | $V^{-1}$ | 0       |
| PODPHIB     | Coefficient for the geometry independent part of DPHIB               | V        | 0       |
| PODPHIBEDGE | Coefficient for the geometry independent part of DPHIBEDGE           | V        | 0       |
| PODVSBNUD   | Coefficient for the geometry independent part of DVSBNUD             | V        | 1       |
| POEF        | Coefficient for the flicker noise frequency exponent                 |          | 1       |
| POEFEDGE    | Coefficient for the geometry independent part of EFEDGE              | _        | 1       |
| POEPSROX    | Coefficient for the geometry independent part of EPSOX               |          | 3.9     |
| POFACNEFFAC | Coefficient for the geometry independent part of FACNEFFAC           | _        | 1       |
| POFETA      | Coefficient for the geometry independent part of FETA                | _        | 1       |
| POFNT       | Coefficient for the geometry independent part of FNT                 | _        | 1       |
| POFNTEDGE   | Coefficient for the geometry independent part of FNTEDGE             | _        | 1       |
| POFNTEXC    | Coefficient for the geometry independent part of FNTEXC              | _        | 0       |
| POGC2       | Coefficient for the geometry independent part of GC2                 | _        | 0.375   |
| POGC3       | Coefficient for the geometry independent part of GC3                 | _        | 0.063   |
| POGCO       | Coefficient for the geometry independent part of GCO                 | _        | 0       |
| POGFACNUD   | Coefficient for the geometry independent part of GFACNUD             | _        | 1       |
| POIGINV     | Coefficient for the geometry independent part of IGINV               | A        | 0       |
| POIGOV      | Coefficient for the geometry independent part of IGOV                | A        | 0       |
| POIGOVD     | Coefficient for the geometry independent part of IGOV for drain side | A        | 0       |
| POKUOWE     | Coefficient for the geometry independent part of KUOWE               | _        | 0       |
| POKVTHOWE   | Coefficient for the geometry independent part of KVTHOWE             | _        | 0       |
| POMUE       | Coefficient for the geometry independent part of MUE                 | m/V      | 0.5     |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units             | Default |
|-------------|---|-------------------|---------|
| PONEFF      | Coefficient for the geometry independent part of NEFF               | $\mathrm{m}^{-3}$ | 5e+23   |
| PONEFFEDGE  | Coefficient for the geometry independent part of NEFFEDGE           | $m^{-3}$          | 5e+23   |
| PONFA       | Coefficient for the geometry independent part of NFA                | _                 | 8e+22   |
| PONFAEDGE   | Coefficient for the geometry independent part of NFAEDGE            | _                 | 8e+22   |
| PONFB       | Coefficient for the geometry independent part of NFB                | _                 | 3e+07   |
| PONFBEDGE   | Coefficient for the geometry independent part of NFBEDGE            | _                 | 3e+07   |
| PONFC       | Coefficient for the geometry independent part of NFC                | $V^{-1}$          | 0       |
| PONFCEDGE   | Coefficient for the geometry independent part of NFCEDGE            | $V^{-1}$          | 0       |
| PONOV       | Coefficient for the geometry independent part of NOV                | $\mathrm{m}^{-3}$ | 5e+25   |
| PONOVD      | Coefficient for the geometry independent part of NOV for drain side | $\mathrm{m}^{-3}$ | 5e+25   |
| PONP        | Coefficient for the geometry independent part of NP                 | $\mathrm{m}^{-3}$ | 1e+26   |
| PONSLP      | Coefficient for the geometry independent part of NSLP               | V                 | 0.05    |
| POPSCE      | Coefficient for the geometry independent part of PSCE               | _                 | 0       |
| POPSCEB     | Coefficient for the geometry independent part of PSCEB              | $V^{-1}$          | 0       |
| POPSCEBEDGE | Coefficient for the geometry independent part of PSCEBEDGE          | $V^{-1}$          | 0       |
| POPSCED     | Coefficient for the geometry independent part of PSCED              | $V^{-1}$          | 0       |
| POPSCEDEDGE | Coefficient for the geometry independent part of PSCEDEDGE          | $V^{-1}$          | 0       |
| POPSCEEDGE  | Coefficient for the geometry independent part of PSCEEDGE           | _                 | 0       |
| PORS        | Coefficient for the geometry independent part of RS                 | Ω                 | 30      |
| PORSB       | Coefficient for the geometry independent part of RSB                | $V^{-1}$          | 0       |
| PORSG       | Coefficient for the geometry independent part of RSG                | $V^{-1}$          | 0       |
| POSTA2      | Coefficient for the geometry independent part of STA2               | V                 | 0       |
| POSTBET     | Coefficient for the geometry independent part of STBET              | _                 | 1       |
| POSTBETEDGE | Coefficient for the geometry independent part of STBETEDGE          | _                 | 1       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description   | Units    | Default |
|-------------|---|----------|---------|
| POSTBGIDL   | Coefficient for the geometry independent part of STBGIDL                | V/K      | 0       |
| POSTBGIDLD  | Coefficient for the geometry independent part of STBGIDL for drain side | V/K      | 0       |
| POSTCS      | Coefficient for the geometry independent part of STCS                   | _        | 0       |
| POSTIG      | Coefficient for the geometry independent part of STIG                   | _        | 2       |
| POSTMUE     | Coefficient for the geometry independent part of STMUE                  | _        | 0       |
| POSTRS      | Coefficient for the geometry independent part of STRS                   | _        | 1       |
| POSTTHEMU   | Coefficient for the geometry independent part of STTHEMU                | _        | 1.5     |
| POSTTHESAT  | Coefficient for the geometry independent part of STTHESAT               |          | 1       |
| POSTVFB     | Coefficient for the geometry independent part of STVFB                  | V/K      | 0.0005  |
| POSTVFBEDGE | Coefficient for the geometry independent part of STVFBEDGE              | V/K      | 0       |
| POSTXCOR    | Coefficient for the geometry independent part of STXCOR                 | _        | 0       |
| POTHEMU     | Coefficient for the geometry independent part of THEMU                  | _        | 1.5     |
| POTHESAT    | Coefficient for the geometry independent part of THESAT                 | $V^{-1}$ | 1       |
| POTHESATB   | Coefficient for the geometry independent part of THESATB                | $V^{-1}$ | 0       |
| POTHESATG   | Coefficient for the geometry independent part of THESATG                | $V^{-1}$ | 0       |
| POTOX       | Coefficient for the geometry independent part of TOX                    | m        | 2e-09   |
| POTOXOV     | Coefficient for the geometry independent part of TOXOV                  | m        | 2e-09   |
| POTOXOVD    | Coefficient for the geometry independent part of TOXOV for drain side   | m        | 2e-09   |
| POVFB       | Coefficient for the geometry independent part of VFB                    | V        | -1      |
| POVFBEDGE   | Coefficient for the geometry independent part of VFBEDGE                | V        | -1      |
| POVNSUB     | Coefficient for the geometry independent part of VNSUB                  | V        | 0       |
| POVP        | Coefficient for the geometry independent part of VP                     | V        | 0.05    |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter    | Description   | Units    | Default |
|--------------|---|----------|---------|
| POVSBNUD     | Coefficient for the geometry independent part of VSBNUD   | V        | 0       |
| POXCOR       | Coefficient for the geometry independent part of XCOR   | $V^{-1}$ | 0       |
| PSCE         | Subthreshold slope coefficient for short channel transistor   |          | 0       |
| PSCEB        | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel transistor        | $V^{-1}$ | 0       |
| PSCEBEDGE    | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors  | $V^{-1}$ | 0       |
| PSCEBEDGEO   | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors  | $V^{-1}$ | 0       |
| PSCEBO       | Bulk voltage dependence parameter of subthreshold slope coefficient for short channel transistor        | $V^{-1}$ | 0       |
| PSCED        | Drain voltage dependence parameter of subthreshold slope coefficient for short channel transistor       | $V^{-1}$ | 0       |
| PSCEDEDGE    | Drain voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors | $V^{-1}$ | 0       |
| PSCEDEDGEO   | Drain voltage dependence parameter of subthreshold slope coefficient for short channel edge transistors | $V^{-1}$ | 0       |
| PSCEDO       | Drain voltage dependence parameter of subthreshold slope coefficient for short channel transistor       | $V^{-1}$ | 0       |
| SCEEDGE      | Subthreshold slope coefficient for short channel edge transistors                                       | _        | 0       |
| PSCEEDGEL    | Length dependence of subthreshold slope coefficient for short channel edge transistors                  | _        | 0       |
| PSCEEDGELEXP | Exponent for length dependence of subthreshold slope coefficient for short channel edge transistors     | _        | 2       |
| PSCEEDGEW    | Exponent for length dependence of subthreshold slope coefficient for short channel edge transistor      | _        | 0       |
| SCEL         | Length dependence of subthreshold slope coefficient for short channel transistor                        |          | 0       |
| SCELEXP      | Exponent for length dependence of subthreshold slope coefficient for short channel transistor           | _        | 2       |
| SCEW         | Exponent for length dependence of subthreshold slope coefficient for short channel transistor           | _        | 0       |
| PSTI         | Grading coefficient of STI-edge component for source-bulk junction                                      | _        | 0.5     |
| STID         | Grading coefficient of STI-edge component for drain-bulk junction                                       | _        | 0.5     |
| PWA1         | Coefficient for the width dependence of A1  | _        | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units                | Default |
|-------------|--|----------------------|---------|
| PWA3        | Coefficient for the width dependence of A3                   | _                    | 0       |
| PWA4        | Coefficient for the width dependence of A4                   | $V^{-1/2}$           | 0       |
| PWAGIDL     | Coefficient for the width dependence of AGIDL                | A/V <sup>3</sup>     | 0       |
| PWAGIDLD    | Coefficient for the width dependence of AGIDL for drain side | A/V <sup>3</sup>     | 0       |
| PWALP       | Coefficient for the width dependence of ALP                  | _                    | 0       |
| PWALP1      | Coefficient for the width dependence of ALP1                 | V                    | 0       |
| PWALP2      | Coefficient for the width dependence of ALP2                 | $V^{-1}$             | 0       |
| PWAX        | Coefficient for the width dependence of AX                   | _                    | 0       |
| PWBETN      | Coefficient for the width dependence of BETN                 | m <sup>2</sup> /(Vs) | 0       |
| PWBETNEDGE  | Coefficient for the width dependence of BETNEDGE             | m <sup>2</sup> /(Vs) | 0       |
| PWCF        | Coefficient for the width dependence of CF                   |                      | 0       |
| PWCFEDGE    | Coefficient for the width dependence of CFEDGE               |                      | 0       |
| PWCFR       | Coefficient for the width dependence of CFR                  | F                    | 0       |
| PWCFRD      | Coefficient for the width dependence of CFR for drain side   | F                    | 0       |
| PWCGBOV     | Coefficient for the width dependence of CGBOV                | F                    | 0       |
| PWCGOV      | Coefficient for the width dependence of CGOV                 | F                    | 0       |
| PWCGOVD     | Coefficient for the width dependence of CGOV for drain side  | F                    | 0       |
| PWCOX       | Coefficient for the width dependence of COX                  | F                    | 0       |
| PWCS        | Coefficient for the width dependence of CS                   | _                    | 0       |
| PWCT        | Coefficient for the width dependence of CT                   | _                    | 0       |
| PWCTEDGE    | Coefficient for the width dependence of CTEDGE               | _                    | 0       |
| PWDELVTAC   | Coefficient for the width dependence of DELVTAC              | V                    | 0       |
| PWDPHIB     | Coefficient for the width dependence of DPHIB                | V                    | 0       |
| PWDPHIBEDGE | Coefficient for the width dependence of DPHIBEDGE            | V                    | 0       |
| PWFACNEFFAC | Coefficient for the width dependence of FACNEFFAC            | _                    | 0       |
| PWFNTEXC    | Coefficient for the width dependence of FNTEXC               | _                    | 0       |
| PWGFACNUD   | Coefficient for the width dependence of GFACNUD              | _                    | 0       |
| PWIGINV     | Coefficient for the width dependence of IGINV                | A                    | 0       |
| PWIGOV      | Coefficient for the width dependence of IGOV                 | A                    | 0       |
| PWIGOVD     | Coefficient for the width dependence of IGOV for drain side  | A                    | 0       |
| PWKUOWE     | Coefficient for the width dependence part of KUOWE           | _                    | 0       |
| PWKVTHOWE   | Coefficient for the width dependence part of KVTHOWE         | _                    | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units                | Default |
|-------------|--|----------------------|---------|
| PWMUE       | Coefficient for the width dependence of MUE                | m/V                  | 0       |
| PWNEFF      | Coefficient for the width dependence of NEFF               | $\mathrm{m}^{-3}$    | 0       |
| PWNEFFEDGE  | Coefficient for the width dependence of NEFFEDGE           | $\mathrm{m}^{-3}$    | 0       |
| PWNFA       | Coefficient for the width dependence of NFA                | _                    | 0       |
| PWNFAEDGE   | Coefficient for the width dependence of NFAEDGE            | _                    | 0       |
| PWNFB       | Coefficient for the width dependence of NFB                | _                    | 0       |
| PWNFBEDGE   | Coefficient for the width dependence of NFBEDGE            |                      | 0       |
| PWNFC       | Coefficient for the width dependence of NFC                | $V^{-1}$             | 0       |
| PWNFCEDGE   | Coefficient for the width dependence of NFCEDGE            | $V^{-1}$             | 0       |
| PWNOV       | Coefficient for the width dependence of NOV                | $m^{-3}$             | 0       |
| PWNOVD      | Coefficient for the width dependence of NOV for drain side | $m^{-3}$             | 0       |
| PWNP        | Coefficient for the width dependence of NP                 | $\mathrm{m}^{-3}$    | 0       |
| PWPSCE      | Coefficient for the width dependence of PSCE               |                      | 0       |
| PWPSCEEDGE  | Coefficient for the width dependence of PSCEEDGE           | _                    | 0       |
| PWRS        | Coefficient for the width dependence of RS                 | Ω                    | 0       |
| PWSTBET     | Coefficient for the width dependence of STBET              | _                    | 0       |
| PWSTBETEDGE | Coefficient for the width dependence of STBETEDGE          | _                    | 0       |
| PWSTTHESAT  | Coefficient for the width dependence of STTHESAT           | _                    | 0       |
| PWSTVFB     | Coefficient for the width dependence of STVFB              | V/K                  | 0       |
| PWSTVFBEDGE | Coefficient for the width dependence of STVFBEDGE          | V/K                  | 0       |
| PWTHESAT    | Coefficient for the width dependence of THESAT             | $V^{-1}$             | 0       |
| PWTHESATB   | Coefficient for the width dependence of THESATB            | $V^{-1}$             | 0       |
| PWTHESATG   | Coefficient for the width dependence of THESATG            | $V^{-1}$             | 0       |
| PWVFB       | Coefficient for the width dependence of VFB                | V                    | 0       |
| PWXCOR      | Coefficient for the width dependence of XCOR               | $V^{-1}$             | 0       |
| QMC         | Quantum-mechanical correction factor                       | _                    | 1       |
| RBULK       | Bulk resistance between node BP and BI                     | Ω                    | 0       |
| RBULKO      | Bulk resistance between node BP and BI                     | Ω                    | 0       |
| RDE         | External drain resistance                                  | Ω                    | 0       |
| RG          | Gate resistance  | Ω                    | 0       |
| RGO         | Gate resistance  | Ω                    | 0       |
| RINT        | Contact resistance between silicide and ploy               | $\Omega \text{ m}^2$ | 0       |
|             |  |                      | 0       |
| RJUND       | Drain-side bulk resistance between node BI and BD          | Ω                    | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units                | Default |
|-------------|--|----------------------|---------|
| RJUNS       | Source-side bulk resistance between node BI and BS           | Ω                    | 0       |
| RJUNSO      | Source-side bulk resistance between node BI and BS           | Ω                    | 0       |
| RS          | Series resistance at TR                                      | Ω                    | 30      |
| RSB         | Back-bias dependence of series resistance                    | $V^{-1}$             | 0       |
| RSBO        | Back-bias dependence of series resistance                    | $V^{-1}$             | 0       |
| RSE         | External source resistance                                   | Ω                    | 0       |
| RSG         | Gate-bias dependence of series resistance                    | $V^{-1}$             | 0       |
| RSGO        | Gate-bias dependence of series resistance                    | $V^{-1}$             | 0       |
| RSH         | Sheet resistance of source diffusion                         | $\Omega/\square$     | 0       |
| RSHD        | Sheet resistance of drain diffusion                          | $\Omega/\Box$        | 0       |
| RSHG        | Gate electrode diffusion sheet resistance                    | $\Omega/\square$     | 0       |
| RSW1        | Source/drain series resistance for 1 um wide channel at TR   | Ω                    | 50      |
| RSW2        | Higher-order width scaling of RS                             | _                    | 0       |
| RTH         | Thermal resistance   | _                    | 0       |
| RTHLW       | Length-correction to width dependence of thermal resistance  | _                    | 0       |
| RTHO        | Geometry independent part of thermal resistance              | _                    | 0       |
| RTHW1       | Width dependence of thermal resistance                       | _                    | 0       |
| RTHW2       | Offset in width dependence of thermal resistance             | _                    | 0       |
| RVPOLY      | Vertical poly resistance                                     | $\Omega \text{ m}^2$ | 0       |
| RWELL       | Well resistance between node BI and B                        | Ω                    | 0       |
| RWELLO      | Well resistance between node BI and B                        | Ω                    | 0       |
| SAREF       | Reference distance between OD-edge and poly from one side    | m                    | 1e-06   |
| SBREF       | Reference distance between OD-edge and poly from other side  | m                    | 1e-06   |
| SCREF       | Distance between OD-edge and well edge of a reference device | m                    | 1e-06   |
| STA2        | Temperature dependence of A2                                 | V                    | 0       |
| STA20       | Temperature dependence of A2                                 | V                    | 0       |
| STBET       | Temperature dependence of BETN                               | _                    | 1       |
| STBETEDGE   | Temperature dependence of BETNEDGE                           | _                    | 1       |
| STBETEDGEL  | Length dependence of temperature dependence of BETNEDGE      | _                    | 0       |
| STBETEDGELW | Area dependence of temperature dependence of BETNEDGE        | _                    | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| STBETEDGEO | Geometry independent temperature dependence of BETNEDGE  | _     | 1       |
| STBETEDGEW | Width dependence of temperature dependence of BETNEDGE   | _     | 0       |
| STBETL     | Length dependence of temperature dependence of BETN  | _     | 0       |
| STBETLW    | Area dependence of temperature dependence of BETN  | _     | 0       |
| STBETO     | Geometry independent temperature dependence of BETN  | _     | 1       |
| STBETW     | Width dependence of temperature dependence of BETN   | _     | 0       |
| STBGIDL    | Temperature dependence of BGIDL  | V/K   | 0       |
| STBGIDLD   | Temperature dependence of BGIDL for drain side   | V/K   | 0       |
| STBGIDLDO  | Temperature dependence of BGIDL for drain side   | V/K   | 0       |
| STBGIDLO   | Temperature dependence of BGIDL  | V/K   | 0       |
| STCS       | Temperature dependence of CS   | _     | 0       |
| STCSO      | Temperature dependence of CS   | _     | 0       |
| STETAO     | Eta0 shift factor related to VTHO change   | m     | 0       |
| STFBBTBOT  | Temperature scaling parameter for band-to-band tunneling of bottom component for source-bulk junction    | 1/K   | -0.001  |
| STFBBTBOTD | Temperature scaling parameter for band-to-band tunneling of bottom component for drain-bulk junction     | 1/K   | -0.001  |
| STFBBTGAT  | Temperature scaling parameter for band-to-band tunneling of gate-edge component for source-bulk junction | 1/K   | -0.001  |
| STFBBTGATD | Temperature scaling parameter for band-to-band tunneling of gate-edge component for drain-bulk junction  | 1/K   | -0.001  |
| STFBBTSTI  | Temperature scaling parameter for band-to-band tunneling of STI-edge component for source-bulk junction  | 1/K   | -0.001  |
| STFBBTSTID | Temperature scaling parameter for band-to-band tunneling of STI-edge component for drain-bulk junction   | 1/K   | -0.001  |
| STIG       | Temperature dependence of IGINV and IGOV   | _     | 2       |
| STIGO      | Temperature dependence of IGINV and IGOV   |       | 2       |
| STMUE      | Temperature dependence of MUE  | _     | 0       |
| STMUEO     | Temperature dependence of MUE  |       | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter   | Description  | Units | Default |
|-------------|--|-------|---------|
| STRS        | Temperature dependence of RS                             | _     | 1       |
| STRSO       | Temperature dependence of RS                             | _     | 1       |
| STRTH       | Temperature sensitivity of RTH                           | _     | 0       |
| STRTHO      | Temperature sensitivity of RTH                           | _     | 0       |
| STTHEMU     | Temperature dependence of THEMU                          | _     | 1.5     |
| STTHEMUO    | Temperature dependence of THEMU                          | _     | 1.5     |
| STTHESAT    | Temperature dependence of THESAT                         | _     | 1       |
| STTHESATL   | Length dependence of temperature dependence of THESAT    | _     | 0       |
| STTHESATLW  | Area dependence of temperature dependence of THESAT      | _     | 0       |
| STTHESATO   | Geometry independent temperature dependence of THESAT    | _     | 1       |
| STTHESATW   | Width dependence of temperature dependence of THESAT     | _     | 0       |
| STVFB       | Temperature dependence of VFB                            | V/K   | 0.0005  |
| STVFBEDGE   | Temperature dependence of VFBEDGE                        | V/K   | 0.0005  |
| STVFBEDGEL  | Length dependence of temperature dependence of VFBEDGE   | V/K   | 0       |
| STVFBEDGELW | Area dependence of temperature dependence of VFBEDGE     | V/K   | 0       |
| STVFBEDGEO  | Geometry-independent temperature dependence of VFBEDGE   | V/K   | 0.0005  |
| STVFBEDGEW  | Width dependence of temperature dependence of VFBEDGE    | V/K   | 0       |
| STVFBL      | Length dependence of temperature dependence of VFB       | V/K   | 0       |
| STVFBLW     | Area dependence of temperature dependence of VFB         | V/K   | 0       |
| STVFBO      | Geometry-independent temperature dependence of VFB       | V/K   | 0.0005  |
| STVFBW      | Width dependence of temperature dependence of VFB        | V/K   | 0       |
| STXCOR      | Temperature dependence of XCOR                           |       | 0       |
| STXCORO     | Temperature dependence of XCOR                           |       | 0       |
| SWDELVTAC   | Flag for separate capacitance calculation; 0=off, 1=on   | _     | 0       |
| SWEDGE      | Flag for drain current of edge transistors; 0=off, 1=on  | _     | 0       |
| SWGEO       | Flag for geometrical model, 0=local, 1=global, 2=binning | _     | 1       |
| SWGIDL      | Flag for GIDL current, 0=turn off IGIDL                  |       | 0       |
| SWIGATE     | Flag for gate current, 0=turn off IG                     | _     | 0       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter  | Description  | Units                | Default |
|------------|--|----------------------|---------|
| SWIGN      | Flag for induced gate noise; 0=off, 1=on   | _                    | 1       |
| SWIMPACT   | Flag for impact ionization current, 0=turn off II  | _                    | 0       |
| SWJUNASYM  | Flag for asymmetric junctions; 0=symmetric, 1=asymmetric                                   | _                    | 0       |
| SWJUNCAP   | Flag for juncap, 0=turn off juncap   |                      | 0       |
| SWJUNEXP   | Flag for JUNCAP-express; 0=full model, 1=express model                                     | _                    | 0       |
| SWNUD      | Flag for NUD-effect; 0=off, 1=on, 2=on+CV-correction                                       | _                    | 0       |
| THEMU      | Mobility reduction exponent at TR  | _                    | 1.5     |
| THEMUO     | Mobility reduction exponent at TR  | _                    | 1.5     |
| THESAT     | Velocity saturation parameter at TR  | $V^{-1}$             | 1       |
| THESATB    | Back-bias dependence of velocity saturation  | $V^{-1}$             | 0       |
| THESATBO   | Back-bias dependence of velocity saturation  | $V^{-1}$             | 0       |
| THESATG    | Gate-bias dependence of velocity saturation  | $V^{-1}$             | 0       |
| THESATGO   | Gate-bias dependence of velocity saturation  | $V^{-1}$             | 0       |
| THESATL    | Length dependence of THESAT  | $V^{-1}$             | 0.05    |
| THESATLEXP | Exponent for length dependence of THESAT   | _                    | 1       |
| THESATLW   | Area dependence of velocity saturation parameter   | _                    | 0       |
| THESATO    | Geometry independent velocity saturation parameter at TR                                   | $V^{-1}$             | 0       |
| THESATW    | Width dependence of velocity saturation parameter  | _                    | 0       |
| TKUO       | Temperature dependence of KUO  |                      | 0       |
| TOX        | Gate oxide thickness   | m                    | 2e-09   |
| TOXO       | Gate oxide thickness   | m                    | 2e-09   |
| TOXOV      | Overlap oxide thickness  | m                    | 2e-09   |
| TOXOVD     | Overlap oxide thickness for drain side   | m                    | 2e-09   |
| TOXOVDO    | Overlap oxide thickness for drain side   | m                    | 2e-09   |
| TOXOVO     | Overlap oxide thickness  | m                    | 2e-09   |
| TR         | nominal (reference) temperature  | °C                   | 21      |
| TRJ        | Reference temperature  | °C                   | 21      |
| TYPE       | Channel type parameter, +1=NMOS -1=PMOS  | _                    | 1       |
| UO         | Zero-field mobility at TR  | m <sup>2</sup> /(Vs) | 0.05    |
| VBIRBOT    | Built-in voltage at the reference temperature of bottom component for source-bulk junction | V                    | 1       |
| VBIRBOTD   | Built-in voltage at the reference temperature of bottom component for drain-bulk junction  | V                    | 1       |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| VBIRGAT   | Built-in voltage at the reference temperature of gate-edge component for source-bulk junction | V     | 1       |
| VBIRGATD  | Built-in voltage at the reference temperature of gate-edge component for drain-bulk junction  | V     | 1       |
| /BIRSTI   | Built-in voltage at the reference temperature of STI-edge component for source-bulk junction  | V     | 1       |
| /BIRSTID  | Built-in voltage at the reference temperature of STI-edge component for drain-bulk junction   | V     | 1       |
| VBRBOT    | Breakdown voltage of bottom component for source-bulk junction                                | V     | 10      |
| VBRBOTD   | Breakdown voltage of bottom component for drain-bulk junction                                 | V     | 10      |
| VBRGAT    | Breakdown voltage of gate-edge component for source-bulk junction                             | V     | 10      |
| VBRGATD   | Breakdown voltage of gate-edge component for drain-bulk junction                              | V     | 10      |
| VBRSTI    | Breakdown voltage of STI-edge component for source-bulk junction                              | V     | 10      |
| VBRSTID   | Breakdown voltage of STI-edge component for drain-bulk junction                               | V     | 10      |
| VFB       | Flat band voltage at TR   | V     | -1      |
| VFBEDGE   | Flat band voltage of edge transistors at TR   | V     | -1      |
| VFBEDGEO  | Geometry-independent flat-band voltage of edge transistors at TR                              | V     | -1      |
| VFBL      | Length dependence of flat-band voltage  | V     | 0       |
| VFBLW     | Area dependence of flat-band voltage  | V     | 0       |
| VFBO      | Geometry-independent flat-band voltage at TR  | V     | -1      |
| VFBW      | Width dependence of flat-band voltage   | V     | 0       |
| VJUNREF   | Typical maximum source-bulk junction voltage; usually about 2*VSUP                            | V     | 2.5     |
| VJUNREFD  | Typical maximum drain-bulk junction voltage; usually about 2*VSUP                             | V     | 2.5     |
| VNSUB     | Effective doping bias-dependence parameter  | V     | 0       |
| VNSUBO    | Effective doping bias-dependence parameter  | V     | 0       |
| VP        | CLM logarithm dependence factor   | V     | 0.05    |
| VPO       | CLM logarithmic dependence parameter  | V     | 0.05    |
| VSBNUD    | Lower Vsb value for NUD-effect  | V     | 0       |
| VSBNUDO   | Lower Vsb value for NUD-effect  | V     | 0       |
| WBET      | Characteristic width for width scaling of BETN  | m     | 1e-09   |

Table 2-122. PSP103VA MOSFET with self-heating Device Model Parameters

| Parameter | Description  | Units    | Default |
|-----------|--|----------|---------|
| WEB       | Coefficient for SCB  | _        | 0       |
| WEC       | Coefficient for SCC  | _        | 0       |
| WEDGE     | Electrical width of edge transistor per side                                   | m        | 1e-08   |
| WEDGEW    | Width dependence of edge WEDGE   | _        | 0       |
| WKUO      | Width dependence of KUO  | _        | 0       |
| WKVTHO    | Width dependence of KVTHO  | _        | 0       |
| WLOD      | Width parameter  | m        | 0       |
| WLODKUO   | Width parameter for UO stress effect   | _        | 0       |
| WLODVTH   | Width parameter for VTH-stress effect  | _        | 0       |
| WMAX      | Dummy parameter to label binning set   | m        | 1       |
| WMIN      | Dummy parameter to label binning set   | m        | 0       |
| WOT       | Effective channel width reduction per side                                     | m        | 0       |
| WSEG      | Char. length of segregation of background doping NSUBO                         | m        | 1e-08   |
| WSEGP     | Char. length of segregation of pocket doping NPCK                              | m        | 1e-08   |
| WVARL     | Length dependence of WVAR  | _        | 0       |
| WVARO     | Geom. independent difference between actual and programmed field-oxide opening | m        | 0       |
| WVARW     | Width dependence of WVAR   | _        | 0       |
| XCOR      | Non-universality factor  | $V^{-1}$ | 0       |
| XCORL     | Length dependence of non-universality parameter                                | _        | 0       |
| XCORLW    | Area dependence of non-universality parameter                                  | _        | 0       |
| XCORO     | Geometry independent non-universality parameter                                | $V^{-1}$ | 0       |
| XCORW     | Width dependence of non-universality parameter                                 | _        | 0       |
| XJUNGAT   | Junction depth of gate-edge component for source-bulk junction                 | m        | 1e-07   |
| XJUNGATD  | Junction depth of gate-edge component for drain-bulk junction                  | m        | 1e-07   |
| XJUNSTI   | Junction depth of STI-edge component for source-bulk junction                  | m        | 1e-07   |
| XJUNSTID  | Junction depth of STI-edge component for drain-bulk junction                   | m        | 1e-07   |

Table 2-123. MOSFET level 1031 Output Variables

| Parameter | Description                       | Units | Default |
|-----------|-----------------------------------|-------|---------|
| ctype     | Flag for channel type             |       | none    |
| sdint     | Flag for source-drain interchange |       | none    |

Table 2-123. MOSFET level 1031 Output Variables

| ise         Total source current         A         none           ige         Total gate current         A         none           ide         Total drain current         A         none           ibe         Total bulk current         A         none           ids         Drain current, excl. edge transistor currents, avalanche, tunnel, GISL, GIDL, and junction currents         A         none           idb         Drain to bulk current         A         none           igb         Gate-bulk tunneling current         A         none           igd         Gate-bulk tunneling current         A         none           igdes         Gate-bulk tunneling current         A         none           igded         Drain current of edge transistors         A         none           igcs         Gate-channel tunneling current (source component)         A         none           igcs         Gate-channel tunneling current (drain component)         A         none           igcs         Gate-channel tunneling current (drain component)         A         none           igtsal         Gate-induced drain leakage current         A         none           igtsal         Gate-induced drain leakage current         A         none           ij  | Parameter | Description                                       | Units         | Default |
|--|-----------|---|---------------|---------|
| ide Total drain current A none ibe Total bulk current A none ids Drain current, excl. edge transistor currents, avalanche, tunnel, GISL, GIDL, and junction currents ids Drain to bulk current A none ids Drain to bulk current A none ids Source to bulk current A none igs Gate-source tunneling current A none idgd Gate-drain tunneling current A none idgd Gate-bulk tunneling current A none idgd Gate-bulk tunneling current A none idges Gate-bulk tunneling current A none idges Gate-channel tunneling current A none idges Gate-channel tunneling current (source component) A none idged Gate-channel tunneling current (drain component) A none idged Gate-channel tunneling current (drain component) A none idged Gate-induced source leakage current A none idgisl Gate-induced source leakage current A none idgisl Gate-induced drain leakage current A none idjslal Gate-induced drain leakage current A none idjsbot Source junction current (bottom component) A none idjsspat Source junction current (bottom component) A none idjsagat Source junction current (gate-edge component) A none idjsdat Source junction current (STI-edge component) A none idjdat Drain junction current (bottom component) A none idjdat Drain junction current (bottom component) A none idjdsti Drain junction current (bottom component) A none idjdsti Drain junction current (bottom component) A none idjdsti Drain junction current (bottom component) A none vods Drain-source voltage V none vods Drain-source voltage including back bias and drain bias effects vods Drain saturation voltage including back bias and drain bias effects vods Drain saturation voltage including back bias and drain bias effects vods Drain saturation voltage including back bias and drain bias effects   | ise       | Total source current                              | A             | none    |
| ibbe Total bulk current A none ids avalanche, tunnel, GISL, GIDL, and junction currents A none isb Source to bulk current A none igg Gate-source tunneling current A none igg Gate-source tunneling current A none igg Gate-drain tunneling current A none iggs Gate-channel tunneling current (source component) A none igg Gate-channel tunneling current (source component) A none igg Gate-channel tunneling current (drain component) A none igg Gate-channel tunneling current (drain component) A none igg Gate-induced source leakage current A none igg Gate-induced source leakage current A none igg Gate-induced drain leakage current A none igg Gate-induced drain leakage current A none igg Gate-induced drain leakage current A none igg Gate-induced Gate induced Gate leakage current A none igg Gate-induced Gate induced Gate leakage current A none igg Gate-induced Gate induced Gate leakage current A none igg Gate-induced Gate induced Gate leakage current A none igg Gate-induced Gate induced Gate leakage current (gate-edge component) A none igg Gate-induced Gate induced Gate induc | ige       | Total gate current                                | A             | none    |
| Drain current, excl. edge transistor currents, avalanche, tunnel, GISL, GIDL, and junction currents avalanche, tunnel, GISL, GIDL, and junction currents avalanche, tunnel, GISL, GIDL, and junction currents avalanche, tunnel in purch avalanche, tunnel in gent avalanche, tunnel in purch avalanche, tunnel in purch avalanche is she was avalanche av | ide       | Total drain current                               | A             | none    |
| avalanche, tunnel, GISL, GIDL, and junction currents A none lish Drain to bulk current A none lish Source to bulk current A none ligs Gate-source tunneling current A none ligs Gate-source tunneling current A none ligd Gate-drain tunneling current A none ligd Gate-bulk tunneling current A none ligd Gate-bulk tunneling current A none ligds Gate-bulk tunneling current A none ligds Gate-channel tunneling current (source component) A none ligds Gate-channel tunneling current (drain component) A none ligds Gate-induced source leakage current A none ligds1 Gate-induced source leakage current A none ligds1 Gate-induced drain leakage current A none ligds1 Gate-induced drain leakage current A none ligsbot Source junction current (bottom component) A none ligsat Source junction current (sate-edge component) A none ligsat Source junction current (STI-edge component) A none ligsat Source junction current (STI-edge component) A none ligsat Source junction current (STI-edge component) A none ligsat Drain junction current (STI-edge component) A none ligdat Drain junction current (STI-edge component) A none ligdsti Drain junction current (STI-edge component) A | ibe       | Total bulk current                                | A             | none    |
| isb Source to bulk current A none igs Gate-source tunneling current A none igd Gate-drain tunneling current A none igd Gate-bulk tunneling current A none igdb Gate-bulk tunneling current A none idedge Drain current of edge transistors A none igcs Gate-channel tunneling current (source component) A none igcd Gate-channel tunneling current (rource component) A none igcd Gate-channel tunneling current of drain component) A none igcd Gate-induced Gate-channel tunneling current (rource component) A none igsis1 Gate-induced source leakage current A none igsis1 Gate-induced drain leakage current A none igsid1 Gate-induced drain leakage current A none ijs Total source junction current (bottom component) A none ijsact Source junction current (gate-edge component) A none ijsast1 Source junction current (STI-edge component) A none ijsast1 Source junction current (STI-edge component) A none ijdd Total drain junction current (STI-edge component) A none ijdspat Drain junction current (gate-edge component) A none ijdsqat Drain junction current (STI-edge component) A none ijdsts1 Drain junction current (STI-edge component) A none vds Drain-source voltage V none vds Drain-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vto Treshold voltage including back bias and drain bias effects vds Drain sauration voltage including back bias and drain bias effects vds Drain sauration voltage at actual bias V none satt Saturation limit Decare of the same of | ids       | <u> </u>  | A             | none    |
| igs Gate-source tunneling current A none igd Gate-drain tunneling current A none igb Gate-bulk tunneling current A none idededge Drain current of edge transistors A none igcs Gate-channel tunneling current (source component) A none igcd Gate-channel tunneling current (source component) A none igcd Gate-channel tunneling current (drain component) A none igcd Gate-channel tunneling current (drain component) A none igcd Gate-induced source leakage current A none igcdlal Gate-induced source leakage current A none igcdlal Gate-induced drain leakage current (bottom component) A none igcdlal Source junction current (gate-edge component) A none igcdlal Total drain junction current (STI-edge component) A none igcdlal Total drain junction current (gate-edge component) A none igcdlat Drain junction current (gate-edge component) A none igcdlat Drain junction current (gate-edge component) A none vods Drain junction current (gate-edge component) A none vods Drain junction current (striege component) A none vods Drain junction current (striege component) A none vods Drain-source voltage V none vods Gate-source voltage V none vods Gate-source voltage V none vods Gate-source voltage V none vods Drain-source voltage V none vods Drain-source voltage including back bias and drain bias effects V none effects V none Potential bias effec | idb       | Drain to bulk current                             | A             | none    |
| igd Gate-drain tunneling current A none igb Gate-bulk tunneling current A none idedge Drain current of edge transistors A none igcs Gate-channel tunneling current (source component) A none igcd Gate-channel tunneling current (drain component) A none igcd Gate-channel tunneling current (drain component) A none igcd Gate-induced source leakage current A none igsis1 Gate-induced source leakage current A none igsis1 Gate-induced drain leakage current A none igsis1 Source junction current (bottom component) A none igsis1 Source junction current (gate-edge component) A none igsis1 Source junction current (gate-edge component) A none igsis1 Total drain junction current (STI-edge component) A none igdbot Drain junction current (bottom component) A none igds1 Drain junction current (gate-edge component) A none igds2 Drain junction current (gate-edge component) A none igds2 Drain junction current (gate-edge component) A none igds3 Drain-source voltage V none vsb Source-bulk voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage including back bias effects V none vth Threshold voltage including back bias and drain bias effects v gate drive voltage including back bias and drain bias effects v none Potts Brain bias effects Drain bias effects v none Potts Drain bias effects Drain bias effects v none Potts  | isb       | Source to bulk current                            | A             | none    |
| igb Gate-bulk tunneling current A none idedge Drain current of edge transistors A none iggs Gate-channel tunneling current (source component) A none iggd Gate-channel tunneling current (source component) A none iggd Gate-channel tunneling current (drain component) A none iggd Gate-channel tunneling current (drain component) A none iggis1 Gate-induced source leakage current A none iggis1 Gate-induced drain leakage current A none iggid1 Gate-induced drain leakage current A none iggid1 Gate-induced drain leakage current A none iggs Source junction current (bottom component) A none iggs Source junction current (gate-edge component) A none iggs Source junction current (gate-edge component) A none iggs Source junction current (STI-edge component) A none iggs Source junction current (STI-edge component) A none iggs Source junction current (bottom component) A none iggs Drain junction current (gate-edge component) A none iggs Source junction current (gate-edge component) A none iggs Gate-source voltage V none voltage including back bias and drain bias V none voltage Drain saturation voltage including back bias and V none voltage Drain saturation voltage including back bias and V none voltage Drain saturation voltage at actual bias V none voltage V none voltage Drain saturation voltage at actual bias V none voltage V none voltage None V none voltage Drain saturation voltage at actual bias V none voltage None None Voltage None None Voltage None None None Voltage None None None None None None None Non       | igs       | Gate-source tunneling current                     | A             | none    |
| idedge Drain current of edge transistors A none igcs Gate-channel tunneling current (source component) A none igcd Gate-channel tunneling current (drain component) A none iav1 Substrate current due to weak avelanche A none igis1 Gate-induced source leakage current A none igis1 Gate-induced drain leakage current A none igid1 Gate-induced drain leakage current A none ijs6 Total source junction current A none ijs8 Total source junction current A none ijs9 Source junction current (bottom component) A none ijs9 Source junction current (gate-edge component) A none ijs9 Source junction current (STI-edge component) A none ijs9 Total drain junction current (STI-edge component) A none ijdd Total drain junction current (bottom component) A none ijddat Drain junction current (gate-edge component) A none ijdgat Drain junction current (gate-edge component) A none ijdsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vto Zero-bias threshold voltage vto Threshold voltage including back bias and drain bias effects vgt Effective gate drive voltage including back bias and drain bias effects vds Drain saturation voltage at actual bias V none vsat Saturation limit O CAL   | igd       | Gate-drain tunneling current                      | A             | none    |
| iggs Gate-channel tunneling current (source component) A none iggd Gate-channel tunneling current (drain component) A none iav1 Substrate current due to weak avelanche A none igis1 Gate-induced source leakage current A none igis1 Gate-induced drain leakage current A none igid1 Gate-induced drain leakage current A none igid1 Gate-induced drain leakage current A none igis2 Total source junction current A none igis2 Source junction current (bottom component) A none igis2 Source junction current (gate-edge component) A none igis3 Source junction current (gate-edge component) A none igis3 Source junction current (STI-edge component) A none igid2 Total drain junction current (STI-edge component) A none igid3 Total drain junction current (bottom component) A none igid3 Drain junction current (gate-edge component) A none igid3 Drain junction current (gate-edge component) A none igid3 Drain junction current (gate-edge component) A none igid3 Drain-source voltage V none volt3 Source-bulk voltage V none volt4 Source-bulk voltage V none volt5 Source-bulk voltage V none volt6 Zero-bias threshold voltage V none volt7 Threshold voltage including back bias and drain bias effects  volt6 Effective gate drive voltage including back bias and drain bias effects  volt7 Effective gate drive voltage including back bias and drain bias effects  volt8 Drain saturation voltage at actual bias V none volt8 Saturation limit none  | igb       | Gate-bulk tunneling current                       | A             | none    |
| igcd Gate-channel tunneling current (drain component) A none iav1 Substrate current due to weak avelanche A none igis1 Gate-induced source leakage current A none igid1 Gate-induced drain leakage current A none igid1 Gate-induced drain leakage current A none igid1 Gate-induced drain leakage current A none ijs Total source junction current A none ijsbot Source junction current (bottom component) A none ijsgat Source junction current (gate-edge component) A none ijsgat Source junction current (STI-edge component) A none ijdd Total drain junction current A none ijddot Drain junction current (bottom component) A none ijddat Drain junction current (bottom component) A none ijddat Drain junction current (gate-edge component) A none ijddsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vto Threshold voltage including back bias and drain bias effects  vgt Effective gate drive voltage including back bias and drain bias effects  V none  vdas Drain saturation voltage at actual bias V none vsat Saturation limit  | idedge    | Drain current of edge transistors                 | A             | none    |
| iav1 Substrate current due to weak avelanche igis1 Gate-induced source leakage current A none igis1 Gate-induced drain leakage current A none igid1 Gate-induced drain leakage current A none ijs Total source junction current A none ijsbot Source junction current (bottom component) A none ijsgat Source junction current (gate-edge component) A none ijsgat Source junction current (STI-edge component) A none ijd Total drain junction current A none ijd jdbot Drain junction current (bottom component) A none ijdsat Drain junction current (gate-edge component) A none ijdsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vto Zero-bias threshold voltage V none vts Threshold voltage including back bias and drain bias effects  vds Drain saturation voltage at actual bias V none vds Saturation limit  Transaction voltage at actual bias V none vsat Saturation limit  | igcs      | Gate-channel tunneling current (source component) | A             | none    |
| igis1 Gate-induced source leakage current A none igid1 Gate-induced drain leakage current A none ijs Total source junction current ijss Total source junction current A none ijssbot Source junction current (bottom component) A none ijsgat Source junction current (gate-edge component) A none ijsgat Source junction current (STI-edge component) A none ijsdat Total drain junction current (STI-edge component) A none ijdbot Drain junction current (bottom component) A none ijdgat Drain junction current (gate-edge component) A none ijdgat Drain junction current (STI-edge component) A none ijdsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vts Threshold voltage including back bias effects V none vth Threshold voltage including back bias and drain bias effects vgt Effective gate drive voltage including back bias and drain bias effects  V none vsat Saturation limit none   | igcd      | Gate-channel tunneling current (drain component)  | A             | none    |
| igidl Gate-induced drain leakage current A none ijs Total source junction current ijsbot Source junction current (bottom component) A none ijsgat Source junction current (gate-edge component) A none ijssti Source junction current (STI-edge component) A none ijd Total drain junction current (STI-edge component) A none ijdbot Drain junction current (bottom component) A none ijdgat Drain junction current (gate-edge component) A none ijdgat Drain junction current (STI-edge component) A none ijdsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vts Threshold voltage including back bias effects V none vth Threshold voltage including back bias and drain bias effects vds Drain saturation voltage at actual bias V none vsat Saturation limit  | iavl      | Substrate current due to weak avelanche           | A             | none    |
| Total source junction current  Source junction current (bottom component)  A none  ijssqt Source junction current (gate-edge component) A none  ijssti Source junction current (STI-edge component) A none  ijd Total drain junction current A none  ijdbot Drain junction current (bottom component) A none  ijdgat Drain junction current (gate-edge component) A none  ijdgat Drain junction current (gate-edge component) A none  ijdsti Drain junction current (STI-edge component) A none  vds Drain-source voltage V none  vgs Gate-source voltage V none  vto Zero-bias threshold voltage V none  vts Threshold voltage including back bias effects V none  vth Effective gate drive voltage including back bias and drain bias effects  vdss Drain saturation voltage at actual bias V none   | igisl     | Gate-induced source leakage current               | A             | none    |
| ijsbot Source junction current (bottom component) A none ijsgat Source junction current (gate-edge component) A none ijssti Source junction current (STI-edge component) A none ijd Total drain junction current A none ijdbot Drain junction current (bottom component) A none ijdgat Drain junction current (gate-edge component) A none ijdgat Drain junction current (gate-edge component) A none ijdsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vts Threshold voltage including back bias effects V none vth Threshold voltage including back bias and drain bias effects vgt Effective gate drive voltage including back bias and drain bias effects vdss Drain saturation voltage at actual bias V none vsat Saturation limit none  | igidl     | Gate-induced drain leakage current                | A             | none    |
| Source junction current (gate-edge component)  A none ijssti Source junction current (STI-edge component)  A none ijd Total drain junction current ijdbot Drain junction current (bottom component)  A none ijdgat Drain junction current (gate-edge component)  A none ijdgat Drain junction current (gate-edge component)  A none ijdsti Drain junction current (STI-edge component)  Vas Drain-source voltage  V none vgs Gate-source voltage  V none vsb Source-bulk voltage  V none vto Zero-bias threshold voltage  V none vts Threshold voltage including back bias and drain bias effects  Vgt  Effective gate drive voltage including back bias and drain bias effects  V none vgs  Saturation limit  Colleged  One  One  One  One  One  One  One  O  | ijs       | Total source junction current                     | A             | none    |
| Source junction current (STI-edge component)  A none  ijd Total drain junction current  A none  ijdbot Drain junction current (bottom component)  A none  ijdgat Drain junction current (gate-edge component)  A none  ijdsti Drain junction current (STI-edge component)  A none  vds Drain-source voltage  V none  vgs Gate-source voltage  V none  vsb Source-bulk voltage  V none  vto Zero-bias threshold voltage  V none  vto Threshold voltage including back bias effects  V none  vth Threshold voltage including back bias and drain bias effects  vgt Effective gate drive voltage including back bias and drain bias effects  vdss Drain saturation voltage at actual bias  V none  vsat Saturation limit none   | ijsbot    | Source junction current (bottom component)        | A             | none    |
| ijd Total drain junction current A none ijdbot Drain junction current (bottom component) A none ijdgat Drain junction current (gate-edge component) A none ijdsti Drain junction current (STI-edge component) A none vds Drain-source voltage V none vgs Gate-source voltage V none vsb Source-bulk voltage V none vto Zero-bias threshold voltage V none vts Threshold voltage including back bias effects V none vth Threshold voltage including back bias and drain bias effects vgt Effective gate drive voltage including back bias and drain bias effects vdss Drain saturation voltage at actual bias V none  vsat Saturation limit Only  | ijsgat    | Source junction current (gate-edge component)     | A             | none    |
| Drain junction current (bottom component)  A none  ijdgat Drain junction current (gate-edge component)  A none  ijdsti Drain junction current (STI-edge component)  Vds Drain-source voltage  V none  vgs Gate-source voltage  V none  vsb Source-bulk voltage  V none  vto Zero-bias threshold voltage  V none  vts Threshold voltage including back bias effects  V none  vth Threshold voltage including back bias and drain bias effects  Vgt Seffective gate drive voltage including back bias and drain bias effects  vds  Drain saturation voltage at actual bias  V none   | ijssti    | Source junction current (STI-edge component)      | A             | none    |
| ijdgat       Drain junction current (gate-edge component)       A       none         ijdsti       Drain junction current (STI-edge component)       A       none         vds       Drain-source voltage       V       none         vgs       Gate-source voltage       V       none         vsb       Source-bulk voltage       V       none         vto       Zero-bias threshold voltage       V       none         vts       Threshold voltage including back bias effects       V       none         vth       Threshold voltage including back bias and drain bias effects       V       none         vgt       Effective gate drive voltage including back bias and drain bias effects       V       none         vdss       Drain saturation voltage at actual bias       V       none         vsat       Saturation limit       none   | ijd       | Total drain junction current                      | A             | none    |
| Drain junction current (STI-edge component)  Vds Drain-source voltage V none  Vgs Gate-source voltage V none  vsb Source-bulk voltage V none  Vto Zero-bias threshold voltage V none  vts Threshold voltage including back bias effects V none  Vth Effective gate drive voltage including back bias and drain bias effects  V none  vgt Sgt Surce-bulk voltage including back bias and drain bias effects V none  Vth Sgt Surration bias effects V none  Vgt Sgt Sgt Sgt Sgt Sgt Sgt Sgt Sgt Sgt S  | ijdbot    | Drain junction current (bottom component)         | A             | none    |
| vds       Drain-source voltage       V       none         vgs       Gate-source voltage       V       none         vsb       Source-bulk voltage       V       none         vto       Zero-bias threshold voltage       V       none         vts       Threshold voltage including back bias effects       V       none         vth       Threshold voltage including back bias and drain bias effects       V       none         vgt       Effective gate drive voltage including back bias and drain bias effects       V       none         vdss       Drain saturation voltage at actual bias       V       none         vsat       Saturation limit       none  | ijdgat    | Drain junction current (gate-edge component)      | A             | none    |
| vgs       Gate-source voltage       V       none         vsb       Source-bulk voltage       V       none         vto       Zero-bias threshold voltage       V       none         vts       Threshold voltage including back bias effects       V       none         vth       Effective gate drive voltage including back bias and drain bias effects       V       none         vgt       Effective gate drive voltage including back bias and drain bias effects       V       none         vdss       Drain saturation voltage at actual bias       V       none         vsat       Saturation limit       none   | ijdsti    | Drain junction current (STI-edge component)       | A             | none    |
| vsb Source-bulk voltage V none  vto Zero-bias threshold voltage V none  vts Threshold voltage including back bias effects V none  vth Threshold voltage including back bias and drain bias effects  vgt Effective gate drive voltage including back bias and drain bias effects  vdss Drain saturation voltage at actual bias V none  vsat Saturation limit none   | vds       | Drain-source voltage                              | V             | none    |
| vto     Zero-bias threshold voltage     V     none       vts     Threshold voltage including back bias effects     V     none       vth     Threshold voltage including back bias and drain bias effects     V     none       vgt     Effective gate drive voltage including back bias and drain bias effects     V     none       vdss     Drain saturation voltage at actual bias     V     none       vsat     Saturation limit     none  | vgs       | Gate-source voltage                               | V             | none    |
| vts       Threshold voltage including back bias effects       V       none         vth       Threshold voltage including back bias and drain bias effects       V       none         vgt       Effective gate drive voltage including back bias and drain bias effects       V       none         vdss       Drain saturation voltage at actual bias       V       none         vsat       Saturation limit       none   | vsb       | Source-bulk voltage                               | V             | none    |
| vth     Threshold voltage including back bias and drain bias effects     V     none       vgt     Effective gate drive voltage including back bias and drain bias effects     V     none       vdss     Drain saturation voltage at actual bias     V     none       vsat     Saturation limit     none  | vto       | Zero-bias threshold voltage                       | V             | none    |
| vgt Effective gate drive voltage including back bias and drain bias effects  vdss Drain saturation voltage at actual bias V none  vsat Saturation limit none   | vts       | Threshold voltage including back bias effects     | V             | none    |
| vdss Drain saturation voltage at actual bias V none vsat Saturation limit none   | vth       | <u> </u>  | V             | none    |
| vsat Saturation limit none   | vgt       | • • •   | V             | none    |
| m 1 .  | vdss      | Drain saturation voltage at actual bias           | V             | none    |
| gm Transconductance $\Omega^{-1}$ none   | vsat      | Saturation limit                                  |               | none    |
|  | gm        | Transconductance                                  | $\Omega^{-1}$ | none    |

Table 2-123. MOSFET level 1031 Output Variables

| · ·   | Parameter | Description                                       | Units            | Default |
|---|-----------|---|------------------|---------|
| Source junction conductance $\Omega^{-1}$ none gid Drain junction conductance $\Omega^{-1}$ none codd Drain junction conductance $\Omega^{-1}$ none codd Drain capacitance F none codd Drain-gate capacitance F none codd Drain-source capacitance F none codd Gate-drain capacitance F none codd Gate-drain capacitance F none codd Gate-drain capacitance F none codd Gate-source capacitance F none codd Gate-bulk capacitance F none codd Source-drain capacitance F none codd Source-drain capacitance F none codd Source-gate capacitance F none codd Source-bulk capacitance F none codd Source-bulk capacitance F none codd Bulk-drain capacitance F none codd Total gate-source overlap capacitance F none codd Total gate-drain overlap capacitance F none codd Total drain junction capacitance (Bottom component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge component) F none codd Total drain junction capacitance (Gate-edge  | gmb       | Substrate transconductance                        | $\Omega^{-1}$    | none    |
| gid Drain junction conductance $\Omega^{-1}$ none codd Drain capacitance $\Gamma$ none codd Drain capacitance $\Gamma$ none codd Drain-source capacitance $\Gamma$ none codd Drain-source capacitance $\Gamma$ none codd Drain-bulk capacitance $\Gamma$ none codd Drain-bulk capacitance $\Gamma$ none codd Gate-drain capacitance $\Gamma$ none codd Gate-drain capacitance $\Gamma$ none codd Gate-drain capacitance $\Gamma$ none codd Gate-source capacitance $\Gamma$ none codd Gate-source capacitance $\Gamma$ none codd Gate-bulk capacitance $\Gamma$ none codd Source-drain capacitance $\Gamma$ none codd Source-bulk capacitance $\Gamma$ none codd Source capacitanc | gds       | Output conductance                                | $\Omega^{-1}$    | none    |
| Drain-gate capacitance F none edg Drain-gate capacitance F none edg Drain-gate capacitance F none edg Gate-drain capacitance F none edg Gate-bulk capacitance F none edg Source-gate capacitance F none edg Source-bulk capacitance F none edg Bulk-drain capacitance F none edg Bulk-gate capacitance F none edg Bulk-gate capacitance F none edg Bulk-source capacitance F none edg Bulk-source capacitance F none edgs Bulk-source capacitance F none edgs Bulk-source capacitance F none edgs Bulk-source overlap capacitance F none edgs Total gate-drain overlap capacitance F none edgs Total source junction capacitance F none edgs Total source junction capacitance F none edgs Source junction capacitance F none edgs Total source junction capacitance (STI-edge component) F none edgs Total drain junction capacitance (STI-edge component) F none edgs Total drain junction capacitance (STI-edge component) F none edgs Total drain junction capacitance (STI-edge component) F none edgs Total drain junction capacitance (STI-edge component) F none edgs Total drain junction capacitance (STI-edge component) F none edgs Total drain junction capacitance (STI-edge component) F none edgs Total source junction capacitance (STI-edge component) F none edgs Total source junction capacitance (STI-edge component) F none edgs Total source junction capacitance (STI-edge component) F none edgs Total source junction capacitance (STI-edge component) F none edgs Total source ju  | gjs       | Source junction conductance                       | $\Omega^{-1}$    | none    |
| Drain-gate capacitance F none cods Drain-source capacitance F none cods Drain-source capacitance F none cods Drain-source capacitance F none codd Gate-drain capacitance F none codd Gate-drain capacitance F none cods Gate-source capacitance F none cods Gate-source capacitance F none cods Gate-bulk capacitance F none codd Gate-Gate Gate Gate Gate Gate Gate Gate Gate  | gjd       | Drain junction conductance                        | $\Omega^{-1}$    | none    |
| Drain-source capacitance F none codb Drain-bulk capacitance F none codd Gate-drain capacitance F none codd Gate-drain capacitance F none codg Gate capacitance F none codg Gate-source capacitance F none codg Gate-bulk capacitance F none codg Gate-bulk capacitance F none codg Gate-bulk capacitance F none codg Source-drain capacitance F none codg Source-drain capacitance F none codg Source-gate capacitance F none codg Source-gate capacitance F none codg Source-bulk capacitance F none codg Source-bulk capacitance F none codg Source-bulk capacitance F none codg Bulk-drain capacitance F none codg Bulk-gate capacitance F none codgol Total gate-source overlap capacitance F none codgol Total gate-drain overlap capacitance F none codgol Total gate-drain overlap capacitance F none codgol Total source junction capacitance F none codgol Source junction capacitance F none codgol Total drain junction capacitance F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (Gate-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total drain junction capacitance (STI-edge component) F none codgol Total STI Drain junction capacitance (STI-edge component) F none codgol Total STI-edge component) F   | cdd       | Drain capacitance                                 | F                | none    |
| Gabe Drain-bulk capacitance F none cogd Gate-drain capacitance F none cogd Gate capacitance F none cogd Gate capacitance F none cogd Gate capacitance F none cogd Gate-bulk capacitance F none cogd Gate-bulk capacitance F none cogd Gate-bulk capacitance F none cogd Source-drain capacitance F none cogd Source-gate capacitance F none cogd Source-bulk capacitance F none cogd Source-bulk capacitance F none cogd Bulk-gate capacitance F none cogd Total gate-drain overlap capacitance F none cogd Total gate-drain overlap capacitance F none cogd Total source junction capacitance F none cogd Total source junction capacitance F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain junction capacitance (STI-edge component) F none cogd Total drain  | cdg       | Drain-gate capacitance                            | F                | none    |
| Gate-drain capacitance F none or Gate capacitance F none or Gate capacitance F none or Gate capacitance F none or Gate-bulk capacitance F none or Gate-bulk capacitance F none or Gate Capacitance Capacitance F none or Gate Capacitance Capacitance Capacitance F none or Gate Capacitance Cap  | cds       | Drain-source capacitance                          | F                | none    |
| Gate capacitance F none caps Gate-source capacitance F none caps Gate-bulk capacitance F none caps Gate-bulk capacitance F none caps Source-gate capacitance F none caps Source-gate capacitance F none caps Source-gate capacitance F none caps Source-bulk capacitance F none caps Source-bulk capacitance F none caps Source-bulk capacitance F none caps Bulk-drain capacitance F none caps Bulk-gate capacitance F none caps Bulk-gate capacitance F none caps Bulk-source overlap capacitance F none caps Total gate-drain overlap capacitance F none caps Total source junction capacitance (pate-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F none caps Total drain junction capacitance (STI-edge component) F non  | cdb       | Drain-bulk capacitance                            | F                | none    |
| Gate-source capacitance F none capb Gate-bulk capacitance F none capb Gate-bulk capacitance F none capacitance Source junction capacitance F none capacitance Source junction capacitance (bottom component) F none capacitance Source junction capacitance (gate-edge component) F none capacitance Source junction capacitance (gate-edge component) F none capacitance Drain junction capacitance (STI-edge component) F none capacitance Capacitance (STI-edge component) F none capacitance Capacitance (pate-edge component) F none capacitance Capa  | cgd       | Gate-drain capacitance                            | F                | none    |
| Gate-bulk capacitance F none casd Source-drain capacitance F none casd Source-gate capacitance F none cass Source capacitance F none casb Source-bulk capacitance F none casb Bulk-gate capacitance F none casb Bulk-source capacitance F none casb Bulk-source overlap capacitance F none casc Bulk-source overlap capacitance F none casc Bulk-source junction capacitance F none casc Total source junction capacitance F none casc Source junction capacitance F none casc Source junction capacitance (bottom component) F none casc Source junction capacitance (gate-edge component) F none casc Source junction capacitance (STI-edge component) F none casc S  | cgg       | Gate capacitance                                  | F                | none    |
| Source-drain capacitance F none css Source-gate capacitance F none css Source capacitance F none csb Source-bulk capacitance F none csb Source-bulk capacitance F none cbd Bulk-drain capacitance F none cbd Bulk-gate capacitance F none cbb Bulk-gate capacitance F none cbb Bulk-source capacitance F none cgsol Total gate-source overlap capacitance F none cgdol Total gate-drain overlap capacitance F none cjss Total source junction capacitance F none cjssol Source junction capacitance F none cjssol Source junction capacitance F none cjssol Source junction capacitance (bottom component) F none cjssti Source junction capacitance (gate-edge component) F none cjssti Source junction capacitance (STI-edge component) F none cjdd Total drain junction capacitance (bottom component) F none cjddst Drain junction capacitance (gate-edge component) F none cjddst Drain junction capacitance (STI-edge component) F none cjddst Drain junction capacitance (state-edge component) F none cjdsti Drain junction capacitance (state-edge co  | cgs       | Gate-source capacitance                           | F                | none    |
| Source-gate capacitance F none cass Source capacitance F none cass Source capacitance F none casb Source-bulk capacitance F none casb Source-bulk capacitance F none casb Bulk-drain capacitance F none casb Bulk-gate capacitance F none casb Bulk-source capacitance F none casb Bulk-source capacitance F none caso Bulk-source capacitance F none caso Total gate-source overlap capacitance F none caso Total gate-drain overlap capacitance F none caso Total source junction capacitance F none caso Source junction capacitance F none caso Source junction capacitance (bottom component) F none caso Source junction capacitance (gate-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (bottom component) F none caso Total drain junction capacitance (bottom component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain junction capacitance (STI-edge component) F none caso Total drain  | cgb       | Gate-bulk capacitance                             | F                | none    |
| Source capacitance F none casb Source-bulk capacitance F none casb Source-bulk capacitance F none casb Bulk-drain capacitance F none casb Bulk-gate capacitance F none casb Bulk-source capacitance F none casb Bulk-source capacitance F none casol Total gate-source overlap capacitance F none casol Total gate-drain overlap capacitance F none casol Total gate-drain overlap capacitance F none casol Total source junction capacitance F none casol Source junction capacitance F none casol Source junction capacitance F none casol Source junction capacitance (gate-edge component) F none casol Source junction capacitance (gate-edge component) F none casol Total drain junction capacitance (STI-edge component) F none casol Total drain junction capacitance (source junction capacitance capaci  | csd       | Source-drain capacitance                          | F                | none    |
| Source-bulk capacitance F none bulk-drain capacitance F none bulk-gate capacitance F none bulk capacitance f none f none bulk capacitance f none bulk capacitance f none f none bulk capacitance f none f none bulk capacitance f none f   | csg       | Source-gate capacitance                           | F                | none    |
| Bulk-drain capacitance F none cbg Bulk-source capacitance F none cbb Bulk capacitance F none ccbb Bulk capacitance F none ccgsol Total gate-source overlap capacitance F none ccgsol Total gate-drain overlap capacitance F none ccjs Total source junction capacitance F none ccjs Total source junction capacitance F none ccjs Source junction capacitance F none ccjsdat Source junction capacitance (bottom component) F none ccjssti Source junction capacitance (gate-edge component) F none ccjssti Source junction capacitance (STI-edge component) F none ccjd Total drain junction capacitance (STI-edge component) F none ccjddat Drain junction capacitance (bottom component) F none ccjdgat Drain junction capacitance (gate-edge component) F none ccjdgat Drain junction capacitance (gate-edge component) F none ccjdsti Drain junction capacitance (gate-edge component) F none ccjdsti Drain junction capacitance (gate-edge component) F none ccjdsti Drain junction capacitance (STI-edge component) F none ccjdsti Drain junction capacitance (Gate-edge component) F none ccjdsti Drain junction capac  | CSS       | Source capacitance                                | F                | none    |
| Bulk-gate capacitance F none  Bulk source capacitance F none  Bulk capacitance F none  Bulk capacitance F none  Bulk capacitance F none  Cogsol Total gate-source overlap capacitance F none  Cogsol Total gate-drain overlap capacitance F none  Cogsol Total source junction capacitance F none  Cojs Total source junction capacitance F none  Cojsgat Source junction capacitance (bottom component) F none  Cojsgat Source junction capacitance (gate-edge component) F none  Cojssti Source junction capacitance (STI-edge component) F none  Cojd Total drain junction capacitance  Cojdot Drain junction capacitance (bottom component) F none  Cojdgat Drain junction capacitance (gate-edge component) F none  Cojdgat Drain junction capacitance (gate-edge component) F none  Cojdsti Drain junction capacitance (STI-edge component) F none  Cojd  | csb       | Source-bulk capacitance                           | F                | none    |
| Bulk-source capacitance F none  Bulk capacitance F none  Bulk capacitance F none  Cogsol Total gate-source overlap capacitance F none  Cogsol Total gate-drain overlap capacitance F none  Cogsol Total source junction capacitance F none  Cojs Total source junction capacitance F none  Cojsol Source junction capacitance (bottom component) F none  Cojsol Source junction capacitance (gate-edge component) F none  Cojsol Source junction capacitance (STI-edge component) F none  Cojsol Total drain junction capacitance F none  Cojd Total drain junction capacitance F none  Cojd Drain junction capacitance (bottom component) F none  Cojdsti Drain junction capacitance (gate-edge component) F none  Cojdsti Drain junction capacitance (STI-edge component) F none  Cojdsti Dr  | cbd       | Bulk-drain capacitance                            | F                | none    |
| Bulk capacitance F none cgsol Total gate-source overlap capacitance F none cgdol Total gate-drain overlap capacitance F none cgdol Total source junction capacitance F none cjs Total source junction capacitance F none cjsbot Source junction capacitance (bottom component) F none cjsgat Source junction capacitance (gate-edge component) F none cjssti Source junction capacitance (STI-edge component) F none cjdd Total drain junction capacitance F none cjddat Drain junction capacitance (bottom component) F none cjdgat Drain junction capacitance (gate-edge component) F none cjdgat Drain junction capacitance (gate-edge component) F none cjdsti Drain junction capacitance (STI-edge component) F none   | cbg       | Bulk-gate capacitance                             | F                | none    |
| Total gate-source overlap capacitance F none cgdol Total gate-drain overlap capacitance F none cjs Total source junction capacitance F none cjsbot Source junction capacitance (bottom component) F none cjsgat Source junction capacitance (gate-edge component) F none cjssti Source junction capacitance (STI-edge component) F none cjd Total drain junction capacitance F none cjdbot Drain junction capacitance (bottom component) F none cjdgat Drain junction capacitance (gate-edge component) F none cjdsti Drain junction capacitance (STI-edge component) F none  | cbs       | Bulk-source capacitance                           | F                | none    |
| Total gate-drain overlap capacitance F none  Cips Total source junction capacitance F none  Cipsbot Source junction capacitance (bottom component) F none  Cipsgat Source junction capacitance (gate-edge component) F none  Cipsgat Source junction capacitance (STI-edge component) F none  Cipsgat Total drain junction capacitance (STI-edge component) F none  Cipd Total drain junction capacitance F none  Cipd Drain junction capacitance (bottom component) F none  Cipdgat Drain junction capacitance (gate-edge component) F none  Cipdgat Drain junction capacitance (STI-edge component) F none  Cipdgat Drain junction capacitance (STI-edge component) F none  Cipdgat Drain junction capacitance (STI-edge component) F none  Cipdgat Effective channel width for geometrical models m none  Cipdgat Effective channel length for geometrical models m none  Cipdgat State  | cbb       | Bulk capacitance                                  | F                | none    |
| Total source junction capacitance F none  Cjsbot Source junction capacitance (bottom component) F none  Cjsgat Source junction capacitance (gate-edge component) F none  Cjssti Source junction capacitance (STI-edge component) F none  Cjd Total drain junction capacitance F none  Cjdbot Drain junction capacitance (bottom component) F none  Cjdgat Drain junction capacitance (gate-edge component) F none  Cjdsti Drain junction capacitance (gate-edge component) F none  Cjdsti Drain junction capacitance (STI-edge component) F none  Cjds  | cgsol     | Total gate-source overlap capacitance             | F                | none    |
| Source junction capacitance (bottom component)  Source junction capacitance (gate-edge component)  Source junction capacitance (gate-edge component)  Source junction capacitance (STI-edge component)  Total drain junction capacitance  Source junction capacitance  Four none  Cjdd  Total drain junction capacitance  Source junction capacitance  Four none  Cjdd  Total drain junction capacitance  Source junction capacitance  Four none  Cjdd  Total drain junction capacitance  Source junction capacitance  Four none  Cjdd  Total drain junction capacitance  (bottom component)  Four none  Cjdgat  Drain junction capacitance (gate-edge component)  Four none  Cjdsti  Drain junction capacitance (STI-edge component)  Four none  Selfective channel width for geometrical models  Transistor gain  Transistor gain  Transistor gain  Transistor gain  Source junction capacitance  Ohm  None  Equivalent Early voltage  Vour none  | cgdol     | Total gate-drain overlap capacitance              | F                | none    |
| Source junction capacitance (gate-edge component) F none  Source junction capacitance (STI-edge component) F none  Total drain junction capacitance F none  Solution capacitance (bottom component) F none  Solution capacitance (bottom component) F none  Solution capacitance (gate-edge component) F none  Solution capacitance (gate-edge component) F none  Solution capacitance (STI-edge component)   | cjs       | Total source junction capacitance                 | F                | none    |
| Source junction capacitance (STI-edge component)  Total drain junction capacitance  Drain junction capacitance (bottom component)  Drain junction capacitance (gate-edge component)  Drain junction capacitance (gate-edge component)  Drain junction capacitance (STI-edge component)  Effective channel width for geometrical models  Effective channel length for geometrical models  Transistor gain  Transistor gain  Small-signal output resistance  Ohm  none  Equivalent Early voltage  V  none   | cjsbot    | Source junction capacitance (bottom component)    | F                | none    |
| Total drain junction capacitance F none  cjdbot Drain junction capacitance (bottom component) F none  cjdgat Drain junction capacitance (gate-edge component) F none  cjdsti Drain junction capacitance (STI-edge component) F none  weff Effective channel width for geometrical models m none  leff Effective channel length for geometrical models m none  Transistor gain none  Small-signal output resistance Ohm none  Equivalent Early voltage V none  | cjsgat    | Source junction capacitance (gate-edge component) | F                | none    |
| Drain junction capacitance (bottom component)  Cidgat  Drain junction capacitance (gate-edge component)  Drain junction capacitance (gate-edge component)  F none  Cidsti  Drain junction capacitance (STI-edge component)  F none  Effective channel width for geometrical models  Effective channel length for geometrical models  Transistor gain  Transistor gain  Small-signal output resistance  Ohm  None  Equivalent Early voltage  V none  | cjssti    | Source junction capacitance (STI-edge component)  | F                | none    |
| Drain junction capacitance (gate-edge component)  Drain junction capacitance (STI-edge component)  Edge to the property of the  | cjd       | Total drain junction capacitance                  | F                | none    |
| Drain junction capacitance (STI-edge component)  Effective channel width for geometrical models  Effective channel length for geometrical models  Transistor gain  Transistor gain  Small-signal output resistance  V none  | cjdbot    | Drain junction capacitance (bottom component)     | F                | none    |
| Effective channel width for geometrical models m none  Effective channel length for geometrical models m none  Transistor gain none  Small-signal output resistance Ohm none  Vearly Equivalent Early voltage V none  | cjdgat    | Drain junction capacitance (gate-edge component)  | F                | none    |
| leff Effective channel length for geometrical models m none Transistor gain none  Small-signal output resistance Ohm none  vearly Equivalent Early voltage V none   | cjdsti    | Drain junction capacitance (STI-edge component)   | F                | none    |
| Transistor gain none  rout Small-signal output resistance Ohm none  vearly Equivalent Early voltage V none  | weff      | Effective channel width for geometrical models    | m                | none    |
| rout Small-signal output resistance Ohm none vearly Equivalent Early voltage V none   | leff      | Effective channel length for geometrical models   | m                | none    |
| vearly Equivalent Early voltage V none  | u         | Transistor gain                                   |                  | none    |
|   | rout      | Small-signal output resistance                    | Ohm              | none    |
| beff Gain factor A/V <sup>2</sup> none  | vearly    | Equivalent Early voltage                          | V                | none    |
|   | beff      | Gain factor                                       | A/V <sup>2</sup> | none    |

Table 2-123. MOSFET level 1031 Output Variables

| Parameter    | Description  | Units              | Default |
|--------------|--|--------------------|---------|
| fug          | Unity gain frequency at actual bias                                | Hz                 | none    |
| rg           | Gate resistance  | Ohm                | none    |
| sfl          | Flicker noise current spectral density at 1 Hz                     | A <sup>2</sup> /Hz | none    |
| sqrtsff      | Input-referred RMS white noise voltage spectral density at 1 kHz   | V/sqrt(Hz)         | none    |
| sqrtsfw      | Input-referred RMS white noise voltage spectral density            | V/sqrt(Hz)         | none    |
| sid          | White noise current spectral density                               | A <sup>2</sup> /Hz | none    |
| sig          | Induced gate noise current spectral density at 1 Hz                | A <sup>2</sup> /Hz | none    |
| cigid        | Imaginary part of correlation coefficient between Sig and Sid      |                    | none    |
| fknee        | Cross-over frequency above which white noise is dominant           | Hz                 | none    |
| sigs         | Gate-source current noise spectral density                         | A <sup>2</sup> /Hz | none    |
| sigd         | Gate-drain current noise spectral density                          | A <sup>2</sup> /Hz | none    |
| siavl        | Impact ionization current noise spectral density                   | A <sup>2</sup> /Hz | none    |
| ssi          | Total source junction current noise spectral density               | A <sup>2</sup> /Hz | none    |
| sdi          | Total drain junction current noise spectral density                | A <sup>2</sup> /Hz | none    |
| sfledge      | Flicker noise current spectral density at 1 Hz of edge transistors | A <sup>2</sup> /Hz | none    |
| sidedge      | White noise current spectral density of edge transistors           | A <sup>2</sup> /Hz | none    |
| lp_vfb       | Local parameter VFB after T-scaling and clipping                   | V                  | none    |
| lp_stvfb     | Local parameter STVFB after clipping                               | V/K                | none    |
| lp_tox       | Local parameter TOX after clipping                                 | m                  | none    |
| lp_epsrox    | Local parameter EPSROX after clipping                              |                    | none    |
| lp_neff      | Local parameter NEFF after clipping                                | $m^{-3}$           | none    |
| lp_facneffac | Local parameter FACNEFFAC after clipping                           |                    | none    |
| lp_gfacnud   | Local parameter GFACNUD after clipping                             |                    | none    |
| lp_vsbnud    | Local parameter VSBNUD after clipping                              | V                  | none    |
| lp_dvsbnud   | Local parameter DVSBNUD after clipping                             | V                  | none    |
| lp_vnsub     | Local parameter VNSUB after clipping                               | V                  | none    |
| lp_nslp      | Local parameter NSLP after clipping                                | V                  | none    |
| lp_dnsub     | Local parameter DNSUB after clipping                               | $V^{-1}$           | none    |
| lp_dphib     | Local parameter DPHIB after clipping                               | V                  | none    |
| lp_delvtac   | Local parameter DELVTAC after clipping                             | V                  | none    |
| lp_np        | Local parameter NP after clipping                                  | $\mathrm{m}^{-3}$  | none    |
| lp_ct        | Local parameter CT after clipping                                  |                    | none    |

Table 2-123. MOSFET level 1031 Output Variables

| Parameter   | Description   | Units             | Default |
|-------------|---|-------------------|---------|
| lp_toxov    | Local parameter TOXOV after clipping                | m                 | none    |
| lp_toxovd   | Local parameter TOXOVD after clipping               | m                 | none    |
| lp_nov      | Local parameter NOV after clipping                  | $\mathrm{m}^{-3}$ | none    |
| lp_novd     | Local parameter NOVD after clipping                 | $\mathrm{m}^{-3}$ | none    |
| lp_cf       | Local parameter CF after clipping                   |                   | none    |
| lp_cfd      | Local parameter CFD after clipping                  | $V^{-1}$          | none    |
| lp_cfb      | Local parameter CFB after clipping                  | $V^{-1}$          | none    |
| lp_psce     | Local parameter PSCE after clipping                 |                   | none    |
| lp_psceb    | Local parameter PSCEB after clipping                | $V^{-1}$          | none    |
| lp_psced    | Local parameter PSCED after clipping                | $V^{-1}$          | none    |
| lp_betn     | Local parameter BETN after T-scaling and clipping   | $m^2/(V s)$       | none    |
| lp_stbet    | Local parameter STBET after clipping                |                   | none    |
| lp_mue      | Local parameter MUE after T-scaling and clipping    | m/V               | none    |
| lp_stmue    | Local parameter STMUE after clipping                |                   | none    |
| lp_themu    | Local parameter THEMU after T-scaling and clipping  |                   | none    |
| lp_stthemu  | Local parameter STTHEMU after clipping              |                   | none    |
| lp_cs       | Local parameter CS after T-scaling and clipping     |                   | none    |
| lp_stcs     | Local parameter STCS after clipping                 |                   | none    |
| lp_xcor     | Local parameter XCOR after T-scaling and clipping   | $V^{-1}$          | none    |
| lp_stxcor   | Local parameter STXCOR after clipping               |                   | none    |
| lp_feta     | Local parameter FETA after clipping                 |                   | none    |
| lp_rs       | Local parameter RS after T-scaling and clipping     | Ohm               | none    |
| lp_strs     | Local parameter STRS after clipping                 |                   | none    |
| lp_rsb      | Local parameter RSB after clipping                  | $V^{-1}$          | none    |
| lp_rsg      | Local parameter RSG after clipping                  | $V^{-1}$          | none    |
| lp_thesat   | Local parameter THESAT after T-scaling and clipping | $V^{-1}$          | none    |
| lp_stthesat | Local parameter STTHESAT after clipping             |                   | none    |
| lp_thesatb  | Local parameter THESATB after clipping              | $V^{-1}$          | none    |
| lp_thesatg  | Local parameter THESATG after clipping              | $V^{-1}$          | none    |
| lp_ax       | Local parameter AX after clipping                   |                   | none    |
| lp_alp      | Local parameter ALP after clipping                  |                   | none    |
| lp_alp1     | Local parameter ALP1 after clipping                 | V                 | none    |
| lp_alp2     | Local parameter ALP2 after clipping                 | $V^{-1}$          | none    |
| lp_vp       | Local parameter VP after clipping                   | V                 | none    |
| lp_a1       | Local parameter A1 after clipping                   |                   | none    |
| lp_a2       | Local parameter A2 after T-scaling and clipping     | V                 | none    |

Table 2-123. MOSFET level 1031 Output Variables

| Parameter    | Description  | Units                 | Default |
|--------------|--|-----------------------|---------|
| lp_sta2      | Local parameter STA2 after clipping                  |                       | none    |
| lp_a3        | Local parameter A3 after clipping                    |                       | none    |
| lp_a4        | Local parameter A4 after clipping                    | 1/sqrt(V)             | none    |
| lp_gco       | Local parameter GCO after clipping                   |                       | none    |
| lp_iginv     | Local parameter IGINV after T-scaling and clipping   | A                     | none    |
| lp_igov      | Local parameter IGOV after T-scaling and clipping    | A                     | none    |
| lp_igovd     | Local parameter IGOVD after T-scaling and clipping   | A                     | none    |
| lp_stig      | Local parameter STIG after clipping                  |                       | none    |
| lp_gc2       | Local parameter GC2 after clipping                   |                       | none    |
| lp_gc3       | Local parameter GC3 after clipping                   |                       | none    |
| lp_chib      | Local parameter CHIB after clipping                  | V                     | none    |
| lp_agidl     | Local parameter AGIDL after clipping                 | A/V <sup>3</sup>      | none    |
| lp_agidld    | Local parameter AGIDLD after clipping                | A/V <sup>3</sup>      | none    |
| lp_bgidl     | Local parameter BGIDL after T-scaling and clipping   | V                     | none    |
| lp_bgidld    | Local parameter BGIDLD after T-scaling and clipping  | V                     | none    |
| lp_stbgidl   | Local parameter STBGIDL after clipping               | V/K                   | none    |
| lp_stbgidld  | Local parameter STBGIDLD after clipping              | V/K                   | none    |
| lp_cgidl     | Local parameter CGIDL after clipping                 |                       | none    |
| lp_cgidld    | Local parameter CGIDLD after clipping                |                       | none    |
| lp_cox       | Local parameter COX after clipping                   | F                     | none    |
| lp_cgov      | Local parameter CGOV after clipping                  | F                     | none    |
| lp_cgovd     | Local parameter CGOVD after clipping                 | F                     | none    |
| lp_cgbov     | Local parameter CGBOV after clipping                 | F                     | none    |
| lp_cfr       | Local parameter CFR after clipping                   | F                     | none    |
| lp_cfrd      | Local parameter CFRD after clipping                  | F                     | none    |
| lp_fnt       | Local parameter FNT after clipping                   |                       | none    |
| lp_fntexc    | Local parameter FNTEXC after clipping                |                       | none    |
| lp_nfa       | Local parameter NFA after clipping                   | 1/(V m <sup>4</sup> ) | none    |
| lp_nfb       | Local parameter NFB after clipping                   | 1/(V m <sup>4</sup> ) | none    |
| lp_nfc       | Local parameter NFC after clipping                   | $V^{-1}$              | none    |
| lp_ef        | Local parameter EF after clipping                    |                       | none    |
| lp_vfbedge   | Local parameter VFBEDGE after T-scaling and clipping | V                     | none    |
| lp_stvfbedge | Local parameter STVFBEDGE after clipping             | V/K                   | none    |
| lp_dphibedge | Local parameter DPHIBEDGE after clipping             | V                     | none    |
| lp_neffedge  | Local parameter NEFFEDGE after clipping              | $m^{-3}$              | none    |

Table 2-123. MOSFET level 1031 Output Variables

| Parameter    | Description  | Units                 | Default |
|--------------|--|-----------------------|---------|
| lp_ctedge    | Local parameter CTEDGE after clipping  |                       | none    |
| lp_betnedge  | Local parameter BETNEDGE after T-scaling and clipping                                    | m <sup>2</sup> /(Vs)  | none    |
| lp_stbetedge | Local parameter STBETEDGE after clipping   |                       | none    |
| lp_psceedge  | Local parameter PSCEEDGE after clipping  |                       | none    |
| lp_pscebedge | Local parameter PSCEBEDGE after clipping   | $V^{-1}$              | none    |
| lp_pscededge | Local parameter PSCEDEDGE after clipping   | $V^{-1}$              | none    |
| lp_cfedge    | Local parameter CFEDGE after clipping  | V                     | none    |
| lp_cfdedge   | Local parameter CFDEDGE after clipping   | $V^{-1}$              | none    |
| lp_cfbedge   | Local parameter CFBEDGE after clipping   | $V^{-1}$              | none    |
| lp_fntedge   | Local parameter FNTEDGE after clipping   |                       | none    |
| lp_nfaedge   | Local parameter NFAEDGE after clipping   | 1/(V m <sup>4</sup> ) | none    |
| lp_nfbedge   | Local parameter NFBEDGE after clipping   | 1/(V m <sup>4</sup> ) | none    |
| lp_nfcedge   | Local parameter NFCEDGE after clipping   | $V^{-1}$              | none    |
| lp_efedge    | Local parameter EFEDGE after clipping  |                       | none    |
| lp_rg        | Local parameter RG after clipping  | Ohm                   | none    |
| lp_rse       | Local parameter RSE after clipping   | Ohm                   | none    |
| lp_rde       | Local parameter RDE after clipping   | Ohm                   | none    |
| lp_rbulk     | Local parameter RBULK after clipping   | Ohm                   | none    |
| lp_rwell     | Local parameter RWELL after clipping   | Ohm                   | none    |
| lp_rjuns     | Local parameter RJUNS after clipping   | Ohm                   | none    |
| lp_rjund     | Local parameter RJUND after clipping   | Ohm                   | none    |
| lp_rth       | Local parameter RTH after T-scaling and clipping   | K/W                   | none    |
| lp_cth       | Local parameter CTH after clipping   | J/K                   | none    |
| lp_strth     | Local parameter STRTH after clipping   |                       | none    |
| pdiss        | Power dissipation  | W                     | none    |
| dtsh         | Temperature rise due to self heating   | K                     | none    |
| tk           | Device Temperature   | K                     | none    |
| cjosbot      | Bottom component of total zero-bias source junction capacitance at device temperature    | F                     | none    |
| cjossti      | STI-edge component of total zero-bias source junction capacitance at device temperature  | F                     | none    |
| cjosgat      | Gate-edge component of total zero-bias source junction capacitance at device temperature | F                     | none    |
| vbisbot      | Built-in voltage of source-side bottom junction at device temperature                    | V                     | none    |
| vbissti      | Built-in voltage of source-side STI-edge junction at device temperature                  | V                     | none    |

Table 2-123. MOSFET level 1031 Output Variables

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| vbisgat    | Built-in voltage of source-side gate-edge junction at device temperature                | V     | none    |
| idsatsbot  | Total source-side bottom junction saturation current                                    | A     | none    |
| idsatssti  | Total source-side STI-edge junction saturation current                                  | A     | none    |
| idsatsgat  | Total source-side gate-edge junction saturation current                                 | A     | none    |
| cjosbotd   | Bottom component of total zero-bias drain junction capacitance at device temperature    | F     | none    |
| cjosstid   | STI-edge component of total zero-bias drain junction capacitance at device temperature  | F     | none    |
| cjosgatd   | Gate-edge component of total zero-bias drain junction capacitance at device temperature | F     | none    |
| vbisbotd   | Built-in voltage of drain-side bottom junction at device temperature                    | V     | none    |
| vbisstid   | Built-in voltage of drain-side STI-edge junction at device temperature                  | V     | none    |
| vbisgatd   | Built-in voltage of drain-side gate-edge junction at device temperature                 | V     | none    |
| idsatsbotd | Total drain-side bottom junction saturation current                                     | A     | none    |
| idsatsstid | Total drain-side STI-edge junction saturation current                                   | A     | none    |
| idsatsgatd | Total drain-side gate-edge junction saturation current                                  | A     | none    |

## 2.3.20.13. Level 110 MOSFET Tables (BSIM CMG version 110.0.0)

Xyce includes the BSIM CMG Common Multi-gate model version 110. The code in Xyce was generated from the BSIM group's Verilog-A input using the default "ifdef" lines provided, and therefore supports only the subset of BSIM CMG features those defaults enable. Instance and model parameters for the BSIM CMG model are given in tables 2-124 and 2-125. Details of the model are documented in the BSIM-CMG technical report[31], available from the BSIM web site at

http://bsim.berkeley.edu/models/bsimcmg/.

The BSIM CMG devices support output of the internal variables in tables 2-129, 2-132, and 2-126 on the .PRINT line of a netlist. To access them from a print line, use the syntax

N (<instance>:<variable>) where "<instance>" refers to the name of the specific level 107 or 108 M device in your netlist.

Table 2-124. BSIM-CMG FINFET v110.0.0 Device Instance Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| ADEJ      | Drain junction area (BULKMOD=1 or 2)                         | $m^2$ | 0       |
| ADEO      | Drain-to-substrate overlap area through oxide                | $m^2$ | 0       |
| ASEJ      | Source junction area (BULKMOD=1 or 2)                        | $m^2$ | 0       |
| ASEO      | Source-to-substrate overlap area through oxide               | $m^2$ | 0       |
| CDSP      | Constant drain-to-source fringe capacitance (all CGEOMOD)    | F     | 0       |
| CGDP      | Constant gate-to-drain fringe capacitance (CGEOMOD=1)        | _     | 0       |
| CGSP      | Constant gate-to-source fringe capacitance (CGEOMOD=1)       | _     | 0       |
| COVD      | Constant gate-to-drain overlap capacitance (CGEOMOD=1)       | _     | 0       |
| COVS      | Constant gate-to-source overlap capacitance (CGEOMOD=1)      | _     | 0       |
| D         | Diameter of the cylinder (GEOMOD=3)                          | m     | 4e-08   |
| FPITCH    | Fin pitch  | m     | 8e-08   |
| L         | Designed gate length   | m     | 3e-08   |
| LRSD      | Length of the source/drain                                   | m     | 0       |
| M         | multiplicity factor  | _     | 1       |
| NF        | Number of fingers  | _     | 1       |
| NFIN      | Number of fins per finger (real number enables optimization) | _     | 1       |
| NFINNOM   | Nominal number of fins per finger                            | _     | 1       |
| NGCON     | Number of gate contact (1 or 2 sided)                        | _     | 1       |
| NRD       | Number of source diffusion squares                           | _     | 0       |
| NRS       | Number of source diffusion squares                           | _     | 0       |

Table 2-124. BSIM-CMG FINFET v110.0.0 Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PDEJ      | Drain-to-substrate PN junction perimeter (BULKMOD=1 or 2)     | m     | 0       |
| PDEO      | Perimeter of drain-to-substrate overlap region through oxide  | m     | 0       |
| PSEJ      | Source-to-substrate PN junction perimeter (BULKMOD=1 or 2)    | m     | 0       |
| PSEO      | Perimeter of source-to-substrate overlap region through oxide | m     | 0       |
| TFIN      | Body (fin) thickness  | m     | 1.5e-08 |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units          | Default   |
|-----------|---|----------------|-----------|
| A1        | Non-saturation effect parameter for strong inversion Region   | _              | 0         |
| A11       | Temperature dependence of A1                                  | _              | 0         |
| A2        | Non-saturation effect parameter for moderate Inversion Region | _              | 0         |
| A21       | Temperature dependence of A2                                  | _              | 0         |
| ACH_UFCM  | Area of the channel for the unified Model                     | m <sup>2</sup> | 1         |
| ADEJ      | Drain junction area (BULKMOD=1 or 2)                          | m <sup>2</sup> | 0         |
| ADEO      | Drain-to-substrate overlap area through oxide                 | m <sup>2</sup> | 0         |
| ADVTP0    | Pre-exponential coefficient for DITS                          | _              | 0         |
| ADVTP1    | Pre-exponential coefficient for DVTP1                         | _              | 0         |
| AEU       | Pre-exponential coefficient for EU                            | _              | 0         |
| AEUR      | Reverse-mode pre-exponential coefficient for EU               | _              | 0         |
| AGIDL     | Pre-exponential coefficient for GIDL                          | _              | 0         |
| AGISL     | Pre-exponential coefficient for GISL                          | _              | 6.055e-12 |
| AIGBACC   | Parameter for Igb in accumulation                             | _              | 0.0136    |
| AIGBACC1  | Parameter for Igb in accumulation                             | _              | 0         |
| AIGBINV   | Parameter for Igb in inversion                                | _              | 0.0111    |
| AIGBINV1  | Parameter for Igb in inversion                                | _              | 0         |
| AIGC      | Parameter for Igc in inversion                                | _              | 0.0136    |
| AIGC1     | Parameter for Igc in inversion                                | _              | 0         |
| AIGD      | Parameter for Igd in inversion                                | _              | 0         |
| AIGD1     | Parameter for Igd in inversion                                | _              | 0         |
| AIGEN     | Thermal generation current parameter                          | _              | 0         |
| AIGS      | Parameter for Igs in inversion                                |                | 0.0136    |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter  | Description  | Units          | Default  |
|------------|--|----------------|----------|
| AIGS1      | Parameter for Igs in inversion   | _              | 0        |
| ALPHA0     | First parameter of Iii   | m/V            | 0        |
| ALPHA01    | Temperature dependence of ALPHA0   | _              | 0        |
| ALPHA1     | L scaling parameter of Iii   | $V^{-1}$       | 0        |
| ALPHA11    | Temperature dependence ALPHA1  | _              | 0        |
| ALPHA_UFCM | Mobile charge scaling term taking QM effects into account                              | _              | 0.5556   |
| ALPHAIIO   | First parameter of Iii for IIMOD=2   | m/V            | 0        |
| ALPHAII01  | Temperature dependence of ALPHAII0   | _              | 0        |
| ALPHAII1   | L scaling parameter of Iii for IIMOD=2   | $V^{-1}$       | 0        |
| ALPHAII11  | Temperature dependence of ALPHAII1   | _              | 0        |
| AMEXP      | Pre-exponential coefficient for MEXP   | _              | 0        |
| AMEXPR     | Pre-exponential coefficient for MEXPR  | _              | 0        |
| APCLM      | Pre-exponential coefficient for PCLM   | _              | 0        |
| APCLMR     | Reverse-mode pre-exponential coefficient for PCLM                                      | _              | 0        |
| APSAT      | Pre-exponential coefficient for PSAT   | _              | 0        |
| APSATCV    | Pre-exponential coefficient for PSATCV   | _              | 0        |
| APTWG      | Pre-exponential coefficient for PTWG   | _              | 0        |
| AQMTCEN    | Parameter for geometric dependence of Tcen on R/TFIN/HFIN                              | _              | 0        |
| ARDSW      | Pre-exponential coefficient for RDSW   | _              | 0        |
| ARDW       | Pre-exponential coefficient for RDW  | _              | 0        |
| ARSDEND    | Extra raised source/drain cross sectional areaat the two ends of the FinFET            | m <sup>2</sup> | 0        |
| ARSW       | Pre-exponential coefficient for RSW  | _              | 0        |
| ASEJ       | Source junction area (BULKMOD=1 or 2)  | m <sup>2</sup> | 0        |
| ASEO       | Source-to-substrate overlap area through oxide   | m <sup>2</sup> | 0        |
| ASHEXP     | Exponent to tune RTH dependence of NFINTOTAL   | _              | 1        |
| ASILIEND   | Extra silicide cross sectional area at the two ends of the FinFET                      | $m^2$          | 0        |
| ASYMMOD    | 0: Turn off asymmetry model - forward mode parameters used; 1: Turn on asymmetry model | _              | 0        |
| AT         | Saturation velocity temperature coefficient  | _              | -0.00156 |
| ATCV       | Saturation velocity temperature coefficient for CV                                     | _              | 0        |
| ATR        | Reverse-mode saturation velocity temperature coefficient                               | _              | 0        |
| AUA        | Pre-exponential coefficient for UA   | _              | 0        |
| AUAR       | Reverse-mode pre-exponential coefficient for UA  | _              | 0        |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units    | Default  |
|-----------|---|----------|----------|
| AUD       | Pre-exponential coefficient for UD                        | _        | 0        |
| AUDR      | Reverse-mode pre-exponential coefficient for UD           | _        | 0        |
| AVSAT     | Pre-exponential coefficient for VSAT                      | _        | 0        |
| AVSAT1    | Pre-exponential coefficient for VSAT1                     | _        | 0        |
| AVSATCV   | Pre-exponential coefficient for VSATCV                    | _        | 0        |
| BDVTP0    | Exponential coefficient for DITS                          | _        | 1e-07    |
| BDVTP1    | Exponential coefficient for DVTP1                         | _        | 1e-07    |
| BETA0     | Vds dependence parameter of Iii                           | $V^{-1}$ | 0        |
| BETAIIO   | Vds dependence parameter of Iii                           | $V^{-1}$ | 0        |
| BETAII1   | Vds dependence parameter of Iii                           | _        | 0        |
| BETAII2   | Vds dependence parameter of Iii                           | V        | 0.1      |
| BEU       | Exponential coefficient for EU                            | _        | 1e-07    |
| BEUR      | Reverse-mode exponential coefficient for EU               |          | 0        |
| BG0SUB    | Bandgap of substrate at 300.15K                           | _        | 1.12     |
| BGIDL     | Exponential coefficient for GIDL                          | _        | 0        |
| BGISL     | Exponential coefficient for GISL                          | _        | 3e+08    |
| BIGBACC   | Parameter for Igb in accumulation                         | _        | 0.00171  |
| BIGBINV   | Parameter for Igb in inversion                            |          | 0.000949 |
| BIGC      | Parameter for Igc in inversion                            |          | 0.00171  |
| BIGD      | Parameter for Igd in inversion                            | _        | 0        |
| BIGEN     | Thermal generation current parameter                      | _        | 0        |
| BIGS      | Parameter for Igs in inversion                            | _        | 0.00171  |
| BMEXP     | Exponential coefficient for MEXP                          | _        | 1        |
| BMEXPR    | Exponential coefficient for MEXPR                         | _        | 0        |
| BPCLM     | Exponential coefficient for PCLM                          | _        | 1e-07    |
| BPCLMR    | Reverse-mode exponential coefficient for PCLM             | _        | 0        |
| BPSAT     | Exponential coefficient for PSAT                          | _        | 1        |
| BPSATCV   | Exponential coefficient for PSATCV                        | _        | 0        |
| BPTWG     | Exponential coefficient for PTWG                          | _        | 1e-07    |
| BQMTCEN   | Parameter for geometric dependence of Tcen on R/TFIN/HFIN | _        | 1.2e-08  |
| BRDSW     | exponential coefficient for RDSW                          | _        | 1e-07    |
| BRDW      | Exponential coefficient for RDW                           | _        | 1e-07    |
| BRSW      | Exponential coefficient for RSW                           | _        | 1e-07    |
| BSHEXP    | Exponent to tune RTH dependence of NF                     | _        | 1        |
| <br>BUA   | Exponential coefficient for UA                            | _        | 1e-07    |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| BUAR      | Reverse-mode exponential coefficient for UAR  | _     | 0       |
| BUD       | Exponential coefficient for UD  |       | 5e-08   |
| BUDR      | Reverse-mode exponential coefficient for UD   | _     | 0       |
| BULKMOD   | 0: SOI multi-gate; 1: Bulk multi-gate; 2: for decoupled bulk multi-gate   | _     | 0       |
| BVD       | Drain diode breakdown voltage   | V     | 0       |
| BVS       | Source diode breakdown voltage  | V     | 10      |
| BVSAT     | Exponential coefficient for VSAT  | _     | 1e-07   |
| BVSAT1    | Exponential coefficient for VSAT1   | _     | 0       |
| BVSATCV   | Exponential coefficient for VSATCV  | _     | 0       |
| CDSC      | Coupling capacitance between S/D and channel  | _     | 0.007   |
| CDSCD     | Drain-bias sensitivity of CDSC  |       | 0.007   |
| CDSCDN1   | NFIN dependence of CDSCD  |       | 0       |
| DSCDN2    | NFIN dependence of CDSCD  |       | 100000  |
| CDSCDR    | Reverse-mode drain-bias sensitivity of CDSC   |       | 0       |
| CDSCDRN1  | NFIN dependence of CDSCD  | _     | 0       |
| CDSCDRN2  | NFIN dependence of CDSCD  | _     | 0       |
| CDSCN1    | NFIN dependence of CDSC   | _     | 0       |
| CDSCN2    | NFIN dependence of CDSC   | _     | 100000  |
| CDSP      | Constant drain-to-source fringe capacitance (all CGEOMOD)   | F     | 0       |
| CFD       | Outer fringe capacitance at drain side  | _     | 0       |
| CFS       | Outer fringe capacitance at source side   | _     | 2.5e-11 |
| CGBL      | Bias dependent component of gate-to-substrate overlap capacitance per unit channel length per finger  | _     | 0       |
| CGBN      | Gate-to-substrate overlap capacitance per unit channel length per fin per finger  | _     | 0       |
| CGBO      | Gate-to-substrate overlap capacitance per unit channel length per finger per NGCON  | _     | 0       |
| CGDL      | Overlap capacitance between gate and lightly-doped drain region (for CGEOMOD = $0, 2$ )   | _     | 0       |
| CGDO      | Non LDD region drain-gate overlap capacitance per unit channel width  | _     | 0       |
| CGDP      | Constant gate-to-drain fringe capacitance (CGEOMOD=1)   | _     | 0       |
| CGEO1SW   | For CGEOMOD=1 only, this switch enables the parameters COVS, COVD, CGSP, and CGDP to be in F per fin, per gate-finger, per unit channel width | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units    | Default |
|-----------|---|----------|---------|
| CGEOA     | Fitting parameter for CGEOMOD=2   |          | 1       |
| CGEOB     | Fitting parameter for CGEOMOD=2   | _        | 0       |
| CGEOC     | Fitting parameter for CGEOMOD=2   | _        | 0       |
| CGEOD     | Fitting parameter for CGEOMOD=2   | _        | 0       |
| CGEOE     | Fitting parameter for CGEOMOD=2   | _        | 1       |
| CGEOMOD   | Geometry-dependent parasitic capacitance model selector                                   | _        | 0       |
| CGIDL     | Parameter for body-effect of GIDL   | _        | 0       |
| CGISL     | Parameter for body-effect of GISL   | _        | 0.5     |
| CGSL      | Overlap capacitance between gate and lightly-doped source region (for CGEOMOD = $0, 2$ )  | _        | 0       |
| CGSO      | Non LDD region source-gate overlap capacitance per unit channel width                     | _        | 0       |
| CGSP      | Constant gate-to-source fringe capacitance (CGEOMOD=1)                                    | _        | 0       |
| CHARGEWF  | Average channel charge weighting factor, +1: source-side, 0: middle, -1: drain-side       |          | 0       |
| CIGBACC   | Parameter for Igb in accumulation   | $V^{-1}$ | 0.075   |
| CIGBINV   | Parameter for Igb in inversion  | $V^{-1}$ | 0.006   |
| CIGC      | Parameter for Igc in inversion  | $V^{-1}$ | 0.075   |
| CIGD      | Parameter for Igd in inversion  | $V^{-1}$ | 0       |
| CIGS      | Parameter for Igs in inversion  | $V^{-1}$ | 0.075   |
| CINS_UFCM | Insulator capacitance for the unified Model   | _        | 1       |
| CIT       | Parameter for interface trap  | _        | 0       |
| CITR      | Parameter for interface trap in reverse mode for asymmetric model                         | _        | 0       |
| CJD       | Unit area drain-side junction capacitance at zero bias                                    | _        | 0       |
| CJS       | Unit area source-side junction capacitance at zero bias                                   | _        | 0.0005  |
| CJSWD     | Unit length drain-side sidewall junction capacitance at zero bias                         | _        | 0       |
| CJSWGD    | Unit length drain-side gate sidewall junction capacitance at zero bias                    |          | 0       |
| CJSWGS    | Unit length source-side gate sidewall junction capacitance at zero bias                   |          | 0       |
| CJSWS     | Unit length source-side sidewall junction capacitance at zero bias                        | _        | 5e-10   |
| CKAPPAB   | Bias dependent gate-to-substrate parasitic capacitance                                    |          | 0.6     |
| CKAPPAD   | Coefficient of bias-dependent overlap capacitance for the drain side (for CGEOMOD = 0, 2) | V        | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| CKAPPAS     | Coefficient of bias-dependent overlap capacitance for the source side (for CGEOMOD = $0, 2$ ) | V     | 0.6     |
| COVD        | Constant gate-to-drain overlap capacitance (CGEOMOD=1)  | _     | 0       |
| COVS        | Constant gate-to-source overlap capacitance (CGEOMOD=1)                                       | _     | 0       |
| CRATIO      | Ratio of the corner area filled with silicon to the total corner area                         | _     | 0.5     |
| CSDESW      | Coefficient for source/drain-to-substrate sidewall capacitance                                | _     | 0       |
| CTH0        | Thermal capacitance   | _     | 1e-05   |
| D           | Diameter of the cylinder (GEOMOD=3)   | m     | 4e-08   |
| DELTAPRSD   | Change in silicon/silicide interface length due to non-rectangular epi                        | m     | 0       |
| DELTAVSAT   | velocity saturation parameter in the linear region  | _     | 1       |
| DELTAVSATCV | Velocity saturation parameter in the linear region for the capacitance model                  | _     | 0       |
| DELTAW      | Change of effective width due to shape of fin/cylinder  | m     | 0       |
| DELTAWCV    | CV change of effective width due to shape of fin/cylinder                                     | m     | 0       |
| DELVFBACC   | Change in flatband voltage: Vfb_accumulation - Vfb_inversion                                  | V     | 0       |
| DELVTRAND   | Variability in Vth  | V     | 0       |
| DEVTYPE     | 0: PMOS; 1: NMOS  | _     | 1       |
| DLBIN       | Delta L for binning   | m     | 0       |
| DLC         | Delta L for C-V model   | m     | 0       |
| DLCACC      | Delta L for C-V model in accumulation region (BULKMOD=1 or 2)                                 | m     | 0       |
| DLCIGD      | Delta L for Igd model   | m     | 0       |
| DLCIGS      | Delta L for Igs model   | m     | 0       |
| DROUT       | L dependence of DIBL effect on Rout   | _     | 1.06    |
| DSUB        | DIBL exponent coefficient   | _     | 1.06    |
| DTEMP       | Variability in device temperature   | °C    | 0       |
| DVT0        | SCE coefficient   | _     | 0       |
| DVT1        | SCE exponent coefficient. After binning it should be within (0:inf)                           | _     | 0.6     |
| DVT1SS      | Subthreshold swing exponent coefficient. After binning it should be within (0:inf)            | _     | 0       |
| DVTP0       | Coefficient for drain-induced Vth shift (DITS)  | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DVTP1     | DITS exponent coefficient  | _     | 0       |
| DVTP2     | DITS model parameter   | _     | 0       |
| DVTSHIFT  | Vth shift handle   | V     | 0       |
| DVTSHIFTR | Vth shift handle for asymmetric mode   | _     | 0       |
| EASUB     | Electron affinity of substrate   | _     | 4.05    |
| EF        | Flicker noise frequency exponent   | _     | 1       |
| EGIDL     | Band bending parameter for GIDL  | V     | 0       |
| EGISL     | Band bending parameter for GISL  | V     | 0.2     |
| EIGBINV   | Parameter for Igb in inversion   | V     | 1.1     |
| EM        | Flicker noise parameter  | _     | 4.1e+07 |
| EMOBT     | Temperature coefficient of ETAMOB  | _     | 0       |
| EOT       | Equivalent oxide thickness   | m     | 1e-09   |
| EOTACC    | Equivalent oxide thickness for accumulation region   | m     | 0       |
| EOTBOX    | Equivalent oxide thickness of the buried oxide (SOI FinFET)                                  | m     | 1.4e-07 |
| EPSROX    | Relative dielectric constant of the gate dielectric  | _     | 3.9     |
| EPSRSP    | Relative dielectric constant of the spacer   | _     | 3.9     |
| EPSRSUB   | Relative dielectric constant of the channel material   |       | 11.9    |
| ESATII    | Saturation channel E-field for Iii   | _     | 1e+07   |
| ETA0      | DIBL coefficient   | _     | 0.6     |
| ETAOLT    | Coupled NFIN and length dependence of ETA0   | _     | 0       |
| ETA0N1    | NFIN dependence of ETA0  | _     | 0       |
| ETA0N2    | NFIN dependence of ETA0  | _     | 100000  |
| ETA0R     | Reverse-mode DIBL coefficient  | _     | 0       |
| ETAMOB    | Effective field parameter  | _     | 2       |
| ETAQM     | Bulk charge coefficient for Tcen   | _     | 0.54    |
| EU        | Phonon/surface roughness scattering parameter  | _     | 2.5     |
| EUR       | Reverse-mode phonon/surface roughness scattering parameter                                   | _     | 0       |
| FECH      | End-channel factor for different orientation/shape   | _     | 1       |
| FECHCV    | CV end-channel factor for different orientation/shape  | _     | 1       |
| FPITCH    | Fin pitch  | m     | 8e-08   |
| GEOMOD    | 0: Double gate; 1: Triple gate; 2: Quadruple gate; 3: Cylindrical gate; 4: Unified fin Shape | _     | 0       |
| GIDLMOD   | 0: Turn off GIDL/GISL current; 1: Turn on GIDL/GISL current                                  | _     | 0       |
| HEPI      | Height of the raised source/drain on top of the fin  | m     | 1e-08   |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter    | Description   | Units | Default |
|--------------|---|-------|---------|
| HFIN         | Fin height  | m     | 3e-08   |
| IDS0MULT     | Variability in drain current for miscellaneous reasons                              |       | 1       |
| IGBMOD       | 0: Turn off Igb; 1: Turn on Igb   | _     | 0       |
| IGCLAMP      | 0: Disable gate current clamps; 1: Enable gate current clamps                       | _     | 1       |
| IGCMOD       | 0: Turn off Igc, Igs and Igd; 1: Turn on Igc, Igs and Igd                           |       | 0       |
| IGT          | Gate current temperature dependence   | _     | 2.5     |
| IIMOD        | 0: Turn off impact ionization current; 1: BSIM4-based model; 2: BSIMSOI-based model | _     | 0       |
| IIMOD2CLAMP1 | Clamp1 of SII1*Vg term in IIMOD=2 model   | V     | 0.1     |
| IIMOD2CLAMP2 | Clamp2 of SII0*Vg term in IIMOD=2 model   | V     | 0.1     |
| IIMOD2CLAMP3 | Clamp3 of Ratio term in IIMOD=2 model   | V     | 0.1     |
| IIT          | Impact ionization temperature dependence for IIMOD = 1                              | _     | -0.5    |
| IJTHDFWD     | Forward drain diode breakdown limiting current                                      | A     | 0       |
| IJTHDREV     | Reverse drain diode breakdown limiting current                                      | A     | 0       |
| IJTHSFWD     | Forward source diode breakdown limiting current                                     | A     | 0.1     |
| IJTHSREV     | Reverse source diode breakdown limiting current                                     | A     | 0.1     |
| IMIN         | Parameter for Vgs clamping for inversion region calculation in accumulation         | _     | 1e-15   |
| JSD          | Bottom drain junction reverse saturation current density                            | _     | 0       |
| JSS          | Bottom source junction reverse saturation current density                           | _     | 0.0001  |
| JSWD         | Unit length reverse saturation current for sidewall drain junction                  | _     | 0       |
| JSWGD        | Unit length reverse saturation current for gate-edge sidewall drain junction        | _     | 0       |
| JSWGS        | Unit length reverse saturation current for gate-edge sidewall source junction       |       | 0       |
| JSWS         | Unit length reverse saturation current for sidewall source junction                 | _     | 0       |
| JTSD         | Bottom drain junction trap-assisted saturation current density                      |       | 0       |
| JTSS         | Bottom source junction trap-assisted saturation current density                     |       | 0       |
| JTSSWD       | Unit length trap-assisted saturation current for sidewall drain junction            | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| JTSSWGD   | Unit length trap-assisted saturation current for gate-edge sidewall drain junction                | _     | 0       |
| JTSSWGS   | Unit length trap-assisted saturation current for gate-edge sidewall source junction               | _     | 0       |
| JTSSWS    | Unit length trap-assisted saturation current for sidewall source junction                         | _     | 0       |
| JTWEFF    | Trap-assisted tunneling current width dependence  | m     | 0       |
| КО        | Lateral NUD voltage parameter   | V     | 0       |
| K01       | Temperature dependence of lateral NUD voltage parameter   | V/K   | 0       |
| KOSI      | Correction factor for strong inversion used in Mnud.<br>After binning it should be within (0:inf) | _     | 1       |
| KOSI1     | Temperature dependence of K0SI  | _     | 0       |
| KOSISAT   | Correction factor for strong inversion used in Mnud   | _     | 0       |
| KOSISAT1  | Temperature dependence of K0SISAT   | _     | 0       |
| K1        | Body effect coefficient for subthreshold region   | _     | 1e-06   |
| K11       | Temperature dependence of K1  | _     | 0       |
| K1RSCE    | K1 for reverse short channel effect calculation   | _     | 0       |
| K2        | Body effect coefficient for BULKMOD==2  | _     | 0       |
| K21       | Temperature dependence of K2  | _     | 0       |
| K2SAT     | Correction factor for K2 in saturation (high Vds)   | _     | 0       |
| K2SAT1    | Temperature dependence of K2SAT   | _     | 0       |
| K2SI      | Correction factor for strong inversion used in Mob  | _     | 0       |
| K2SI1     | Temperature dependence of K2SI  | _     | 0       |
| K2SISAT   | Correction factor for strong inversion used in Mob  | _     | 0       |
| K2SISAT1  | Temperature dependence of K2SISAT   | _     | 0       |
| KSATIV    | Parameter for long channel Vdsat  | _     | 1       |
| KSATIVR   | KSATIV in asymmetric mode   | _     | 0       |
| KT1       | Vth temperature coefficient   | V     | 0       |
| KT1L      | Vth temperature L coefficient   | _     | 0       |
| L         | Designed gate length  | m     | 3e-08   |
| LA1       |   | _     | 0       |
| LA11      |   | _     | 0       |
| LA2       |   | _     | 0       |
| LA21      |   | _     | 0       |
| LAGIDL    |   | _     | 0       |
| LAGISL    |   |       | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| LAIGBACC  |             | _     | 0       |
| LAIGBACC1 |             | _     | 0       |
| LAIGBINV  |             | _     | 0       |
| LAIGBINV1 |             | _     | 0       |
| LAIGC     |             | _     | 0       |
| LAIGC1    |             | _     | 0       |
| LAIGD     |             | _     | 0       |
| LAIGD1    |             | _     | 0       |
| LAIGEN    |             | _     | 0       |
| LAIGS     |             | _     | 0       |
| LAIGS1    |             | _     | 0       |
| LALPHA0   |             | _     | 0       |
| LALPHA1   |             | m/V   | 0       |
| LALPHAIIO |             | _     | 0       |
| LALPHAII1 |             | m/V   | 0       |
| LAT       |             | _     | 0       |
| LATCV     |             | _     | 0       |
| LATR      |             | _     | 0       |
| LBETA0    |             | m/V   | 0       |
| LBETAIIO  |             | m/V   | 0       |
| LBETAII1  |             | _     | 0       |
| LBETAII2  |             | _     | 0       |
| LBGIDL    |             | V     | 0       |
| LBGISL    |             | V     | 0       |
| LBIGBACC  |             | _     | 0       |
| LBIGBINV  |             | _     | 0       |
| LBIGC     |             | _     | 0       |
| LBIGD     |             | _     | 0       |
| LBIGEN    |             | _     | 0       |
| LBIGS     |             | _     | 0       |
| LCDSC     |             | _     | 0       |
| LCDSCD    |             | _     | 0       |
| LCDSCDR   |             | _     | 0       |
| LCFD      |             | F     | 0       |
| LCFS      |             | F     | 0       |
| LCGBL     |             | F     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter Descrip | ption Units | Default |
|-------------------|-------------|---------|
| LCGDL             | F           | 0       |
| LCGIDL            | _           | 0       |
| LCGISL            | _           | 0       |
| LCGSL             | F           | 0       |
| LCIGBACC          | m/V         | 0       |
| LCIGBINV          | m/V         | 0       |
| LCIGC             | m/V         | 0       |
| LCIGD             | m/V         | 0       |
| LCIGS             | m/V         | 0       |
| LCIT              | _           | 0       |
| LCITR             | _           | 0       |
| LCKAPPAB          | _           | 0       |
| LCKAPPAD          | _           | 0       |
| LCKAPPAS          | _           | 0       |
| LCOVD             | F           | 0       |
| LCOVS             | F           | 0       |
| LDELTAVSAT        | _           | 0       |
| LDELTAVSATCV      | _           | 0       |
| LDROUT            | _           | 0       |
| LDSUB             | _           | 0       |
| LDVT0             | _           | 0       |
| LDVT1             | _           | 0       |
| LDVT1SS           | _           | 0       |
| LDVTB             | _           | 0       |
| LDVTSHIFT         | _           | 0       |
| LDVTSHIFTR        | _           | 0       |
| LEGIDL            | _           | 0       |
| LEGISL            | _           | 0       |
| LEIGBINV          | _           | 0       |
| LEMOBT            |             | 0       |
| LESATII           | V           | 0       |
| LETA0             |             | 0       |
| LETA0R            |             | 0       |
| LETAMOB           | _           | 0       |
| LEU               |             | 0       |
| LEUR              | _           | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units          | Default |
|-----------|--|----------------|---------|
| LIGT      |  | _              | 0       |
| LII       | Channel length dependence parameter of Iii           | _              | 5e-10   |
| LIIT      |  | _              | 0       |
| LINT      | Length reduction parameter (dopant diffusion effect) | m              | 0       |
| LINTIGEN  | Lint for thermal generation current                  | m              | 0       |
| LINTNOI   | L offset for flicker noise calculation               | m <sup>2</sup> | 0       |
| LK0       |  | _              | 0       |
| LK01      |  | _              | 0       |
| LK0SI     |  | _              | 0       |
| LK0SI1    |  | _              | 0       |
| LK0SISAT  |  | _              | 0       |
| LK0SISAT1 |  |                | 0       |
| LK1       |  |                | 0       |
| LK11      |  |                | 0       |
| LK1RSCE   |  | _              | 0       |
| LK2       |  | _              | 0       |
| LK21      |  | _              | 0       |
| LK2SAT    |  | _              | 0       |
| LK2SAT1   |  | _              | 0       |
| LK2SI     |  | _              | 0       |
| LK2SI1    |  | _              | 0       |
| LK2SISAT  |  | _              | 0       |
| LK2SISAT1 |  | _              | 0       |
| LKSATIV   |  | _              | 0       |
| LKSATIVR  |  | _              | 0       |
| LKT1      |  | _              | 0       |
| LL        | Length reduction parameter (dopant diffusion effect) | _              | 0       |
| LLC       | Length reduction parameter (dopant diffusion effect) | _              | 0       |
| LLII      |  | _              | 0       |
| LLN       | Length reduction parameter (dopant diffusion effect) | _              | 1       |
| LLPE0     |  | m <sup>2</sup> | 0       |
| LLPEB     |  | _              | 0       |
| LMEXP     |  | _              | 0       |
| LMEXPR    |  | _              | 0       |
| LNBODY    |  | _              | 0       |
| LNGATE    |  | _              | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter  | Description                                     | Units    | Default |
|------------|---|----------|---------|
| LNIGBACC   |   | _        | 0       |
| LNIGBINV   |   | _        | 0       |
| LNTGEN     |   | _        | 0       |
| LNTOX      |   | _        | 0       |
| LPA        | Mobility L power coefficient                    | _        | 1       |
| LPAR       | Reverse-mode mobility L power coefficient       | _        | 0       |
| LPCLM      |   | _        | 0       |
| LPCLMCV    |   | _        | 0       |
| LPCLMG     |   | _        | 0       |
| LPCLMR     |   | _        | 0       |
| LPDIBL1    |   | _        | 0       |
| LPDIBL1R   |   | _        | 0       |
| LPDIBL2    |   | _        | 0       |
| LPDIBL2R   |   | _        | 0       |
| LPE0       | Equivalent length of pocket region at zero bias | m        | 5e-09   |
| LPGIDL     |   | _        | 0       |
| LPGISL     |   | _        | 0       |
| LPHIBE     |   | _        | 0       |
| LPHIG      |   | _        | 0       |
| LPHIN      |   | _        | 0       |
| LPIGCD     |   | _        | 0       |
| LPOXEDGE   |   | _        | 0       |
| LPRT       |   | _        | 0       |
| LPRWGD     |   | m/V      | 0       |
| LPRWGS     |   | m/V      | 0       |
| LPSAT      |   | _        | 0       |
| LPSATCV    |   |          | 0       |
| LPTWG      |   |          | 0       |
| LPTWGR     |   |          | 0       |
| LPTWGT     |   | _        | 0       |
| LPVAG      |   |          | 0       |
| LQMFACTOR  |   | _        | 0       |
| LQMTCENCV  |   |          | 0       |
| LQMTCENCVA |   | <u> </u> | 0       |
| LRDSW      |   |          | 0       |
| LRDW       |   |          | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter   | Description                           | Units    | Default |
|-------------|---------------------------------------|----------|---------|
| LRSD        | Length of the source/drain            | m        | 0       |
| LRSW        |                                       | _        | 0       |
| LSIIO       |                                       | m/V      | 0       |
| LSII1       |                                       | _        | 0       |
| LSII2       |                                       | _        | 0       |
| LSIID       |                                       | _        | 0       |
| LSP         | Thickness of the gate sidewall spacer | m        | 0       |
| LSTTHETASAT |                                       | _        | 0       |
| LTGIDL      |                                       | _        | 0       |
| LTII        |                                       | _        | 0       |
| LTSS        |                                       | _        | 0       |
| LU0         |                                       |          | 0       |
| LU0R        |                                       |          | 0       |
| LUA         |                                       | _        | 0       |
| LUA1        |                                       | _        | 0       |
| LUA1R       |                                       | _        | 0       |
| LUAR        |                                       | _        | 0       |
| LUC         |                                       | _        | 0       |
| LUC1        |                                       | _        | 0       |
| LUC1R       |                                       | _        | 0       |
| LUCR        |                                       | _        | 0       |
| LUCS        |                                       | _        | 0       |
| LUCSTE      |                                       | _        | 0       |
| LUD         |                                       | _        | 0       |
| LUD1        |                                       | _        | 0       |
| LUD1R       |                                       | _        | 0       |
| LUDR        |                                       |          | 0       |
| LUP         |                                       |          | 0       |
| LUPR        |                                       |          | 0       |
| LUTE        |                                       | _        | 0       |
| LUTER       |                                       |          | 0       |
| LUTL        |                                       |          | 0       |
| LUTLR       |                                       | <u> </u> | 0       |
| LVSAT       |                                       | _        | 0       |
| LVSAT1      |                                       | _        | 0       |
| LVSAT1R     |                                       | _        | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LVSATCV   |  | _     | 0       |
| LVSATR    |  | _     | 0       |
| LWR       |  | _     | 0       |
| LXRCRG1   |  |       | 0       |
| LXRCRG2   |  | _     | 0       |
| MEXP      | Smoothing function factor for Vdsat  | _     | 4       |
| MEXPR     | Reverse-mode smoothing function factor for Vdsat                                   | _     | 0       |
| MJD       | Drain bottom junction capacitance grading coefficient                              | _     | 0       |
| MJD2      | Drain bottom two-step second junction capacitance grading coefficient              | _     | 0       |
| MJS       | Source bottom junction capacitance grading coefficient                             | _     | 0.5     |
| MJS2      | Source bottom two-step second junction capacitance grading coefficient             |       | 0.125   |
| MJSWD     | Drain sidewall junction capacitance grading coefficient                            | _     | 0       |
| MJSWD2    | Drain sidewall two-step second junction capacitance grading coefficient            | _     | 0       |
| MJSWGD    | Drain-side gate sidewall junction capacitance grading coefficient                  | _     | 0       |
| MJSWGD2   | Drain-side gate sidewall two-step second junction capacitance grading coefficient  | _     | 0       |
| MJSWGS    | Source-side gate sidewall junction capacitance grading coefficient                 | _     | 0       |
| MJSWGS2   | Source-side gate sidewall two-step second junction capacitance grading coefficient | _     | 0       |
| MJSWS     | Source sidewall junction capacitance grading coefficient                           | _     | 0.33    |
| MJSWS2    | Source sidewall two-step second junction capacitance grading coefficient           | _     | 0.083   |
| NA1       |  |       | 0       |
| NA11      |  |       | 0       |
| NA2       |  |       | 0       |
| NA21      |  |       | 0       |
| NAGIDL    |  |       | 0       |
| NAGISL    |  |       | 0       |
| NAIGBACC  |  | _     | 0       |
| NAIGBACC1 |  | _     | 0       |
| NAIGBINV  |  | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description                              | Units | Default  |
|-----------|--|-------|----------|
| NAIGBINV1 |  | _     | 0        |
| NAIGC     |  | _     | 0        |
| NAIGC1    |  | _     | 0        |
| NAIGD     |  | _     | 0        |
| NAIGD1    |  | _     | 0        |
| NAIGEN    |  | _     | 0        |
| NAIGS     |  | _     | 0        |
| NAIGS1    |  | _     | 0        |
| NALPHA0   |  | _     | 0        |
| NALPHA1   |  | m/V   | 0        |
| NALPHAIIO |  | _     | 0        |
| NALPHAII1 |  | m/V   | 0        |
| NAT       |  | _     | 0        |
| NATCV     |  | _     | 0        |
| NATR      |  | _     | 0        |
| NBETA0    |  | m/V   | 0        |
| NBETAIIO  |  | m/V   | 0        |
| NBETAII1  |  | _     | 0        |
| NBETAII2  |  | _     | 0        |
| NBGIDL    |  | V     | 0        |
| NBGISL    |  | V     | 0        |
| NBIGBACC  |  | _     | 0        |
| NBIGBINV  |  | _     | 0        |
| NBIGC     |  | _     | 0        |
| NBIGD     |  | _     | 0        |
| NBIGEN    |  | _     | 0        |
| NBIGS     |  | _     | 0        |
| NBODY     | Channel (body) doping                    | _     | 1e+22    |
| NBODYN1   | NFIN dependence of channel (body) doping | _     | 0        |
| NBODYN2   | NFIN dependence of channel (body) doping | _     | 100000   |
| NC0SUB    | Conduction band density of states        | _     | 2.86e+25 |
| NCDSC     |  | _     | 0        |
| NCDSCD    |  | _     | 0        |
| NCDSCDR   |  | _     | 0        |
| NCFD      |  | F     | 0        |
| NCFS      |  | F     | 0        |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter Descriptio | On Units    | Default |
|----------------------|-------------|---------|
| NCGBL                | F           | 0       |
| NCGDL                | F           | 0       |
| NCGIDL               | _           | 0       |
| NCGISL               | _           | 0       |
| NCGSL                | F           | 0       |
| NCIGBACC             | m/V         | 0       |
| NCIGBINV             | m/V         | 0       |
| NCIGC                | m/V         | 0       |
| NCIGD                | m/V         | 0       |
| NCIGS                | m/V         | 0       |
| NCIT                 | _           | 0       |
| NCITR                | _           | 0       |
| NCKAPPAB             | _           | 0       |
| NCKAPPAD             | _           | 0       |
| NCKAPPAS             | _           | 0       |
| NCOVD                | F           | 0       |
| NCOVS                | F           | 0       |
| NDELTAVSAT           | _           | 0       |
| NDELTAVSATCV         | _           | 0       |
| NDROUT               | _           | 0       |
| NDSUB                | _           | 0       |
| NDVT0                | _           | 0       |
| NDVT1                | _           | 0       |
| NDVT1SS              | _           | 0       |
| NDVTB                | _           | 0       |
| NDVTSHIFT            | _           | 0       |
| NDVTSHIFTR           | _           | 0       |
| NEGIDL               | _           | 0       |
| NEGISL               | _           | 0       |
| NEIGBINV             | <del></del> | 0       |
| NEMOBT               |             | 0       |
| NESATII              | V           | 0       |
| NETA0                |             | 0       |
| NETA0R               |             | 0       |
| NETAMOB              |             | 0       |
| NEU                  | _           | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| NEUR      |   | _     | 0       |
| NF        | Number of fingers   | _     | 1       |
| NFIN      | Number of fins per finger (real number enables optimization)        | _     | 1       |
| NGATE     | Parameter for poly gate doping. For metal gate please set NGATE = 0 | _     | 0       |
| NGCON     | Number of gate contact (1 or 2 sided)                               | _     | 1       |
| NIOSUB    | Intrinsic carrier constant at 300.15K                               | _     | 1.1e+16 |
| NIGBACC   | Parameter for Igb in accumulation                                   | _     | 1       |
| NIGBINV   | Parameter for Igb in inversion                                      | _     | 3       |
| NIGT      |   | _     | 0       |
| NIIT      |   | _     | 0       |
| NJD       | Drain junction emission coefficient                                 | _     | 0       |
| NJS       | Source junction emission coefficient                                | _     | 1       |
| NJTS      | Non-ideality factor for JTSS  | _     | 20      |
| NJTSD     | Non-ideality factor for JTSD  | _     | 0       |
| NJTSSW    | Non-ideality factor for JTSSWS                                      | _     | 20      |
| NJTSSWD   | Non-ideality factor for JTSSWD                                      | _     | 0       |
| NJTSSWG   | Non-ideality factor for JTSSWGS                                     | _     | 20      |
| NJTSSWGD  | Non-ideality factor for JTSSWGD                                     | _     | 0       |
| NK0       |   | _     | 0       |
| NK01      |   | _     | 0       |
| NKOSI     |   | _     | 0       |
| NK0SI1    |   | _     | 0       |
| NKOSISAT  |   | _     | 0       |
| NKOSISAT1 |   | _     | 0       |
| NK1       |   | _     | 0       |
| NK11      |   | _     | 0       |
| NK1RSCE   |   | _     | 0       |
| NK2       |   | _     | 0       |
| NK21      |   | _     | 0       |
| NK2SAT    |   | _     | 0       |
| NK2SAT1   |   | _     | 0       |
| NK2SI     |   | _     | 0       |
| NK2SI1    |   | _     | 0       |
| NK2SISAT  |   | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description             | Units | Default   |
|-----------|-------------------------|-------|-----------|
| NK2SISAT1 |                         | _     | 0         |
| NKSATIV   |                         | _     | 0         |
| NKSATIVR  |                         | _     | 0         |
| NKT1      |                         | _     | 0         |
| NLII      |                         | _     | 0         |
| NLPE0     |                         | $m^2$ | 0         |
| NLPEB     |                         | _     | 0         |
| NMEXP     |                         | _     | 0         |
| NMEXPR    |                         | _     | 0         |
| NNBODY    |                         | _     | 0         |
| NNGATE    |                         | _     | 0         |
| NNIGBACC  |                         | _     | 0         |
| NNIGBINV  |                         | _     | 0         |
| NNTGEN    |                         | _     | 0         |
| NNTOX     |                         | _     | 0         |
| NOIA      | Flicker noise parameter | _     | 6.25e+39  |
| NOIB      | Flicker noise parameter | _     | 3.125e+24 |
| NOIC      | Flicker noise parameter | _     | 8.75e+07  |
| NPCLM     |                         | _     | 0         |
| NPCLMCV   |                         | _     | 0         |
| NPCLMG    |                         | _     | 0         |
| NPCLMR    |                         | _     | 0         |
| NPDIBL1   |                         | _     | 0         |
| NPDIBL1R  |                         | _     | 0         |
| NPDIBL2   |                         | _     | 0         |
| NPDIBL2R  |                         | _     | 0         |
| NPGIDL    |                         | _     | 0         |
| NPGISL    |                         | _     | 0         |
| NPHIBE    |                         | _     | 0         |
| NPHIG     |                         | _     | 0         |
| NPHIN     |                         | _     | 0         |
| NPIGCD    |                         | _     | 0         |
| NPOXEDGE  |                         | _     | 0         |
| NPRT      |                         | _     | 0         |
| NPRWGD    |                         | m/V   | 0         |
| NPRWGS    |                         | m/V   | 0         |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter   | Description  | Units | Default |
|-------------|--|-------|---------|
| NPSAT       |  | _     | 0       |
| NPSATCV     |  | _     | 0       |
| NPTWG       |  | _     | 0       |
| NPTWGR      |  | _     | 0       |
| NPTWGT      |  | _     | 0       |
| NPVAG       |  | _     | 0       |
| NQMFACTOR   |  | _     | 0       |
| NQMTCENCV   |  | _     | 0       |
| NQMTCENCVA  |  | _     | 0       |
| NQSMOD      | 0: Turn off NQS model; 1: NQS gate resistance (with gi node); 2: NQS charge deficit model from BSIM4 (with q node) |       | 0       |
| NRD         | Number of source diffusion squares   | _     | 0       |
| NRDSW       |  |       | 0       |
| NRDW        |  | _     | 0       |
| NRS         | Number of source diffusion squares   | _     | 0       |
| NRSW        |  | _     | 0       |
| NSD         | Source/drain active doping concentration   | _     | 2e+26   |
| NSDE        | Source/drain active doping concentration at Leff edge  | _     | 2e+25   |
| NSEG        | Number of segments for NQSMOD=3 (3, 5 and 10 supported)  | _     | 4       |
| NSIIO       |  | m/V   | 0       |
| NSII1       |  | _     | 0       |
| NSII2       |  | _     | 0       |
| NSIID       |  | _     | 0       |
| NSTTHETASAT |  | _     | 0       |
| NTGEN       | Thermal generation current parameter   | _     | 1       |
| NTGIDL      |  | _     | 0       |
| NTII        |  |       | 0       |
| NTNOI       | Thermal noise parameter  |       | 1       |
| NTOX        | Exponent for Tox ratio   |       | 1       |
| NTSS        |  |       | 0       |
| NU0         |  | _     | 0       |
| NU0R        |  | _     | 0       |
| NUA         |  | _     | 0       |
| NUA1        |  | _     | 0       |
| NUA1R       |  | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| NUAR      |   | _     | 0       |
| NUC       |   | _     | 0       |
| NUC1      |   | _     | 0       |
| NUC1R     |   | _     | 0       |
| NUCR      |   | _     | 0       |
| NUCS      |   | _     | 0       |
| NUCSTE    |   | _     | 0       |
| NUD       |   | _     | 0       |
| NUD1      |   | _     | 0       |
| NUD1R     |   | _     | 0       |
| NUDR      |   | _     | 0       |
| NUP       |   | _     | 0       |
| NUPR      |   | _     | 0       |
| NUTE      |   | _     | 0       |
| NUTER     |   | _     | 0       |
| NUTL      |   | _     | 0       |
| NUTLR     |   | _     | 0       |
| NVSAT     |   | _     | 0       |
| NVSAT1    |   | _     | 0       |
| NVSAT1R   |   | _     | 0       |
| NVSATCV   |   | _     | 0       |
| NVSATR    |   | _     | 0       |
| NVTM      | Subthreshold swing factor multiplied by Vtm. If defined by user, it will overwrite nVtm in the code | V     | 0       |
| NWR       |   | _     | 0       |
| NXRCRG1   |   |       | 0       |
| NXRCRG2   |   | _     | 0       |
| PA1       |   |       | 0       |
| PA11      |   | _     | 0       |
| PA2       |   |       | 0       |
| PA21      |   |       | 0       |
| PAGIDL    |   | _     | 0       |
| PAGISL    |   | _     | 0       |
| PAIGBACC  |   | _     | 0       |
| PAIGBACC1 |   | _     | 0       |
| PAIGBINV  |   | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PAIGBINV1 |   | _     | 0       |
| PAIGC     |   | _     | 0       |
| PAIGC1    |   | _     | 0       |
| PAIGD     |   |       | 0       |
| PAIGD1    |   | _     | 0       |
| PAIGEN    |   | _     | 0       |
| PAIGS     |   | _     | 0       |
| PAIGS1    |   | _     | 0       |
| PALPHA0   |   | _     | 0       |
| PALPHA1   |   | _     | 0       |
| PALPHAIIO |   | _     | 0       |
| PALPHAII1 |   | _     | 0       |
| PAT       |   |       | 0       |
| PATCV     |   | _     | 0       |
| PATR      |   | _     | 0       |
| PBD       | Drain-side bulk junction built-in potential                           | V     | 0       |
| PBETA0    |   | _     | 0       |
| PBETAIIO  |   | _     | 0       |
| PBETAII1  |   | _     | 0       |
| PBETAII2  |   | _     | 0       |
| PBGIDL    |   | _     | 0       |
| PBGISL    |   | _     | 0       |
| PBIGBACC  |   | _     | 0       |
| PBIGBINV  |   | _     | 0       |
| PBIGC     |   | _     | 0       |
| PBIGD     |   | _     | 0       |
| PBIGEN    |   | _     | 0       |
| PBIGS     |   | _     | 0       |
| PBS       | Source-side bulk junction built-in potential                          | V     | 1       |
| PBSWD     | Built-in potential for Drain-side sidewall junction capacitance       | V     | 0       |
| PBSWGD    | Built-in potential for Drain-side gate sidewall junction capacitance  | V     | 0       |
| PBSWGS    | Built-in potential for Source-side gate sidewall junction capacitance | V     | 0       |
| PBSWS     | Built-in potential for Source-side sidewall junction capacitance      | V     | 1       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter    | Description  | Units | Default |
|--------------|--|-------|---------|
| PCDSC        |  | F     | 0       |
| PCDSCD       |  | F     | 0       |
| PCDSCDR      |  | F     | 0       |
| PCFD         |  |       | 0       |
| PCFS         |  | _     | 0       |
| PCGBL        |  | _     | 0       |
| PCGDL        |  | _     | 0       |
| PCGIDL       |  | _     | 0       |
| PCGISL       |  | _     | 0       |
| PCGSL        |  |       | 0       |
| PCIGBACC     |  | _     | 0       |
| PCIGBINV     |  | _     | 0       |
| PCIGC        |  | _     | 0       |
| PCIGD        |  |       | 0       |
| PCIGS        |  | _     | 0       |
| PCIT         |  | F     | 0       |
| PCITR        |  | _     | 0       |
| PCKAPPAB     |  | _     | 0       |
| PCKAPPAD     |  | _     | 0       |
| PCKAPPAS     |  | _     | 0       |
| PCLM         | Channel length modulation (CLM) parameter                    | _     | 0.013   |
| PCLMCV       | CLM parameter for short-channel CV                           | _     | 0       |
| PCLMG        | Gate bias dependence parameter for CLM                       | _     | 0       |
| PCLMR        | Reverse model PCLM parameter                                 |       | 0       |
| PCOVD        |  | _     | 0       |
| PCOVS        |  | _     | 0       |
| PDEJ         | Drain-to-substrate PN junction perimeter (BULKMOD=1 or 2)    | m     | 0       |
| PDELTAVSAT   |  | _     | 0       |
| PDELTAVSATCV |  | _     | 0       |
| PDEO         | Perimeter of drain-to-substrate overlap region through oxide | m     | 0       |
| PDIBL1       | DIBL output conductance parameter - forward mode             | _     | 1.3     |
| PDIBL1R      | DIBL output conductance parameter - reverse mode             | _     | 0       |
| PDIBL2       | DIBL output conductance parameter                            | _     | 0.0002  |
| PDIBL2R      | DIBL output conductance parameter - reverse mode             | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| PDROUT     |  | _     | 0       |
| PDSUB      |  | _     | 0       |
| PDVT0      |  | _     | 0       |
| PDVT1      |  | _     | 0       |
| PDVT1SS    |  | _     | 0       |
| PDVTB      |  | _     | 0       |
| PDVTSHIFT  |  | _     | 0       |
| PDVTSHIFTR |  |       | 0       |
| PEGIDL     |  |       | 0       |
| PEGISL     |  | _     | 0       |
| PEIGBINV   |  | _     | 0       |
| PEMOBT     |  | _     | 0       |
| PESATII    |  | _     | 0       |
| PETA0      |  | _     | 0       |
| PETA0R     |  | _     | 0       |
| PETAMOB    |  | _     | 0       |
| PEU        |  | _     | 0       |
| PEUR       |  | _     | 0       |
| PGIDL      | Parameter for body-bias effect on GIDL                                     | _     | 0       |
| PGISL      | Parameter for body-bias effect on GISL                                     | _     | 1       |
| PHIBE      | Body effect voltage parameter. After binning it should be within [0.2:1.2] | V     | 0.7     |
| PHIG       | Gate workfunction  | _     | 4.61    |
| PHIGL      | Length dependence of gate workfunction                                     | _     | 0       |
| PHIGLT     | Coupled NFIN and length dependence of gate workfunction                    | _     | 0       |
| PHIGN1     | NFIN dependence of gate workfunction                                       | _     | 0       |
| PHIGN2     | NFIN dependence of gate workfunction                                       | _     | 100000  |
| PHIN       | Nonuniform vertical doping effect on surface potential                     | V     | 0.05    |
| PIGCD      | Parameter for Igc partition  | _     | 1       |
| PIGT       |  | _     | 0       |
| PIIT       |  | _     | 0       |
| PK0        |  | _     | 0       |
| PK01       |  | _     | 0       |
| PKOSI      |  | _     | 0       |
| PK0SI1     |  | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description                  | Units | Default |
|-----------|------------------------------|-------|---------|
| PK0SISAT  |                              | _     | 0       |
| PK0SISAT1 |                              | _     | 0       |
| PK1       |                              | _     | 0       |
| PK11      |                              | _     | 0       |
| PK1RSCE   |                              | _     | 0       |
| PK2       |                              | _     | 0       |
| PK21      |                              | _     | 0       |
| PK2SAT    |                              | _     | 0       |
| PK2SAT1   |                              | _     | 0       |
| PK2SI     |                              | _     | 0       |
| PK2SI1    |                              | _     | 0       |
| PK2SISAT  |                              | _     | 0       |
| PK2SISAT1 |                              | _     | 0       |
| PKSATIV   |                              | _     | 0       |
| PKSATIVR  |                              | _     | 0       |
| PKT1      |                              | _     | 0       |
| PLII      |                              | _     | 0       |
| PLPE0     |                              | _     | 0       |
| PLPEB     |                              | _     | 0       |
| PMEXP     |                              | _     | 0       |
| PMEXPR    |                              | _     | 0       |
| PNBODY    |                              | _     | 0       |
| PNGATE    |                              | _     | 0       |
| PNIGBACC  |                              | _     | 0       |
| PNIGBINV  |                              | _     | 0       |
| PNTGEN    |                              | _     | 0       |
| PNTOX     |                              | _     | 0       |
| POXEDGE   | Factor for the gate edge Tox | _     | 1       |
| PPCLM     |                              | _     | 0       |
| PPCLMCV   |                              | _     | 0       |
| PPCLMG    |                              | _     | 0       |
| PPCLMR    |                              | _     | 0       |
| PPDIBL1   |                              | _     | 0       |
| PPDIBL1R  |                              | _     | 0       |
| PPDIBL2   |                              | _     | 0       |
| PPDIBL2R  |                              | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter  | Description  | Units    | Default |
|------------|--|----------|---------|
| PPGIDL     |  | _        | 0       |
| PPGISL     |  | _        | 0       |
| PPHIBE     |  | _        | 0       |
| PPHIG      |  | _        | 0       |
| PPHIN      |  | _        | 0       |
| PPIGCD     |  | _        | 0       |
| PPOXEDGE   |  | _        | 0       |
| PPRT       |  | _        | 0       |
| PPRWGD     |  | _        | 0       |
| PPRWGS     |  | _        | 0       |
| PPSAT      |  | _        | 0       |
| PPSATCV    |  | _        | 0       |
| PPTWG      |  | _        | 0       |
| PPTWGR     |  | _        | 0       |
| PPTWGT     |  | _        | 0       |
| PPVAG      |  | _        | 0       |
| PQM        | Slope of normalized Tcen in inversion                                    | _        | 0.66    |
| PQMACC     | Slope of normalized Tcen in accumulation                                 | _        | 0.66    |
| PQMFACTOR  |  |          | 0       |
| PQMTCENCV  |  | _        | 0       |
| PQMTCENCVA |  | _        | 0       |
| PRDDR      | Drain-side quasi-saturation parameter                                    | _        | 0       |
| PRDSW      |  | _        | 0       |
| PRDW       |  | _        | 0       |
| PRSDEND    | Extra silicon/silicide interface perimeter at the two ends of the FinFET | m        | 0       |
| PRSDR      | Source-side quasi-saturation parameter                                   | _        | 1       |
| PRSW       |  | _        | 0       |
| PRT        | Series resistance temperature coefficient                                | _        | 0.001   |
| PRWGD      | Gate bias dependence of drain extension resistance                       | $V^{-1}$ | 0       |
| PRWGS      | Gate bias dependence of source extension resistance                      | $V^{-1}$ | 0       |
| PSAT       | Velocity saturation exponent, after binnig should be from [2.0:inf)      | _        | 2       |
| PSATCV     | Velocity saturation exponent for C-V                                     | _        | 0       |
| PSEJ       | Source-to-substrate PN junction perimeter (BULKMOD=1 or 2)               | m        | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| PSEO        | Perimeter of source-to-substrate overlap region through oxide | m     | 0       |
| PSII0       |   | _     | 0       |
| PSII1       |   | _     | 0       |
| PSII2       |   | _     | 0       |
| PSIID       |   | _     | 0       |
| PSTTHETASAT |   | _     | 0       |
| PTGIDL      |   | _     | 0       |
| PTII        |   | _     | 0       |
| PTSS        |   | _     | 0       |
| PTWG        | Gmsat degradation parameter - forward mode                    | _     | 0       |
| PTWGR       | Gmsat degradation parameter - reverse mode                    | _     | 0       |
| PTWGT       | PTWG temperature coefficient                                  | _     | 0.004   |
| PU0         |   | _     | 0       |
| PU0R        |   | _     | 0       |
| PUA         |   | _     | 0       |
| PUA1        |   | _     | 0       |
| PUA1R       |   | _     | 0       |
| PUAR        |   | _     | 0       |
| PUC         |   | _     | 0       |
| PUC1        |   | _     | 0       |
| PUC1R       |   | _     | 0       |
| PUCR        |   | _     | 0       |
| PUCS        |   | _     | 0       |
| PUCSTE      |   | _     | 0       |
| PUD         |   | _     | 0       |
| PUD1        |   | _     | 0       |
| PUD1R       |   | _     | 0       |
| PUDR        |   | _     | 0       |
| PUP         |   | _     | 0       |
| PUPR        |   | _     | 0       |
| PUTE        |   | _     | 0       |
| PUTER       |   | _     | 0       |
| PUTL        |   | _     | 0       |
| PUTLR       |   | _     | 0       |
| PVAG        | Vgs dependence on early voltage                               | _     | 1       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| PVSAT      |  | _     | 0       |
| PVSAT1     |  | _     | 0       |
| PVSAT1R    |  | _     | 0       |
| PVSATCV    |  | _     | 0       |
| PVSATR     |  | _     | 0       |
| PWR        |  | _     | 0       |
| PXRCRG1    |  | _     | 0       |
| PXRCRG2    |  | _     | 0       |
| QM0        | Knee-point for Tcen in inversion (Charge normalized to Cox)  | V     | 0.001   |
| QM0ACC     | Knee-point for Tcen in accumulation (Charge normalized to Cox)   | V     | 0.001   |
| QMFACTOR   | Prefactor + switch for QM Vth correction   | _     | 0       |
| QMFACTORCV | Charge dependence taking QM effects into account   | _     | 0       |
| QMTCENCV   | Prefactor + switch for QM Width and Toxeff correction for CV   | _     | 0       |
| QMTCENCVA  | Prefactor + switch for QM Width and Toxeff correction for CV (accumulation region)   | _     | 0       |
| RDDR       | Drain-side drift resistance parameter - forward mode   | _     | 0       |
| RDDRR      | Drain-side drift resistance parameter - reverse mode   | _     | 0       |
| RDSMOD     | 0: Internal S/D resistance model; 1: External S/D resistance model; 2: Both bias dependent and independent part of S/D resistance internal | _     | 0       |
| RDSW       | RDSMOD = 0 zero bias S/D extension resistance per unit width   | _     | 100     |
| RDSWMIN    | RDSMOD = 0 S/D extension resistance per unit width at high Vgs   | _     | 0       |
| RDW        | RDSMOD = 1 zero bias drain extension resistance per unit width   | _     | 50      |
| RDWMIN     | RDSMOD = 1 drain extension resistance per unit width at high Vgs   | _     | 0       |
| RGATEMOD   | 0: Turn off gate electrode resistance (without ge node); 1: Turn on gate electrode resistance (with ge node)                               | _     | 0       |
| RGEOA      | Fitting parameter for RGEOMOD=1  | _     | 1       |
| RGEOB      | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOC      | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOD      | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOE      | Fitting parameter for RGEOMOD=1  | _     | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description   | Units    | Default |
|-----------|---|----------|---------|
| RGEOMOD   | Geometry-dependent source/drain resistance; 0: RSH-based; 1: Holistic | _        | 0       |
| RGEXT     | Effective gate electrode external resistance                          | _        | 0       |
| RGFIN     | Effective gate electrode per finger per fin resistance                | _        | 0.001   |
| RHOC      | Contact resistivity at the silicon/silicide interface                 | _        | 1e-12   |
| RHORSD    | Average resistivity of silicon in the raised source/drain region      | _        | 1       |
| RNOIA     | Thermal noise coefficient   |          | 0.577   |
| RNOIB     | Thermal noise coefficient   | _        | 0.37    |
| RNOIC     | Thermal noise coefficient for TNOIMOD=1                               |          | 0.395   |
| RSDR      | Source-side drift resistance parameter - forward mode                 | _        | 0       |
| RSDRR     | Source-side drift resistance parameter - reverse mode                 | _        | 0       |
| RSHD      | Drain-side sheet resistance   | _        | 0       |
| RSHS      | Source-side sheet resistance  | _        | 0       |
| RSW       | RDSMOD = 1 zero bias source extension resistance per unit width       | _        | 50      |
| RSWMIN    | RDSMOD = 1 source extension resistance per unit width at high Vgs     | _        | 0       |
| RTH0      | Thermal resistance  | _        | 0.01    |
| SCALEN    | Noise scaling parameter for TNOIMOD=1                                 | _        | 100000  |
| SDTERM    | Indicator of whether the source/drain are terminated with silicide    | _        | 0       |
| SH_WARN   | 0: Disable self-heating warnings; 1: Enable self-heating warnings     | _        | 0       |
| SHMOD     | 0: Turn off self-heating; 1: Turn on self-heating                     | _        | 0       |
| SIIO      | Vgs dependence parameter of Iii                                       | $V^{-1}$ | 0.5     |
| SII1      | 1st Vgs dependence parameter of Iii                                   | _        | 0.1     |
| SII2      | 2nd Vgs dependence parameter of Iii                                   | V        | 0       |
| SIID      | 3rd Vds dependence parameter of Iii                                   | V        | 0       |
| SJD       | Constant for drain-side two-step second junction                      | _        | 0       |
| SJS       | Constant for source-side two-step second junction                     | _        | 0       |
| SJSWD     | Constant for drain-side sidewall two-step second junction             | _        | 0       |
| SJSWGD    | Constant for source-side gate sidewall two-step second junction       | _        | 0       |
| SJSWGS    | Constant for source-side gate sidewall two-step second junction       | _        | 0       |
| SJSWS     | Constant for source-side sidewall two-step second junction            | _        | 0       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units | Default  |
|-----------|--|-------|----------|
| TBGASUB   | Bandgap temperature coefficient  | _     | 0.000702 |
| TBGBSUB   | Bandgap temperature coefficient  | K     | 1108     |
| TCJ       | Temperature coefficient for CJS/CJD  | _     | 0        |
| TCJSW     | Temperature coefficient for CJSWS/CJSWD  | _     | 0        |
| TCJSWG    | Temperature coefficient for CJSWGS/CJSWGD  | _     | 0        |
| TEMPMOD   | 1: Change temperature dependence of specific parameters  | _     | 0        |
| TETA0     | Temperature dependence of DIBL coefficient   | _     | 0        |
| TETAOR    | Temperature dependence of reverse-mode DIBL coefficient  | _     | 0        |
| TFIN      | Body (fin) thickness   | m     | 1.5e-08  |
| TFIN_BASE | Base body (fin) thickness for trapezoidal triple gate  | m     | 1.5e-08  |
| TFIN_TOP  | Top body (fin) thickness for trapezoidal triple gate   | m     | 1.5e-08  |
| TGATE     | Gate height on top of the hard mask  | m     | 3e-08    |
| TGIDL     | GIDL/GISL temperature dependence   | _     | -0.003   |
| THETADIBL | DIBL length dependence. If defined by user, will overwrite Theta_DIBL in the code                | _     | 0        |
| THETASCE  | Vth roll-off length dependence. If defined by user, it will overwrite Theta_SCE in the code      | _     | 0        |
| THETASW   | Subthreshold swing length dependence. If defined by user, it will overwrite Theta_SW in the code | _     | 0        |
| TII       | Impact ionization temperature dependence for IIMOD = 2   | _     | 0        |
| TMASK     | Height of hard mask on top of the fin  | m     | 3e-08    |
| TMEXP     | Temperature coefficient for Vdseff smoothing   | _     | 0        |
| TMEXPR    | Reverse-mode temperature coefficient for Vdseff smoothing  | _     | 0        |
| TNJTS     | Temperature coefficient for NJTS   | _     | 0        |
| TNJTSD    | Temperature coefficient for NJTSD  | _     | 0        |
| TNJTSSW   | Temperature coefficient for NJTSSW   | _     | 0        |
| TNJTSSWD  | Temperature coefficient for NJTSSWD  | _     | 0        |
| TNJTSSWG  | Temperature coefficient for NJTSSWG  | _     | 0        |
| TNJTSSWGD | Temperature coefficient for NJTSSWGD   | _     | 0        |
| TNOIA     | Thermal noise parameter  | _     | 1.5      |
| TNOIB     | Thermal noise parameter  | _     | 3.5      |
| TNOIC     | Thermal noise parameter for TNOIMOD=1  | _     | 3.5      |
| TNOIMOD   | 0: Charge-based, 1: Correlated thermal noise model   | _     | 0        |
| TNOM      | Temperature at which the model is extracted  | _     | 27       |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units | Default   |
|-----------|--|-------|-----------|
| TOXG      | Oxide thickness for gate current model                                       | m     | 0         |
| TOXP      | Physical oxide thickness   | m     | 1.2e-09   |
| TOXREF    | Target tox value   | m     | 1.2e-09   |
| TPB       | Temperature coefficient for PBS/PBD  | _     | 0         |
| TPBSW     | Temperature coefficient for PBSWS/PBSWD                                      | _     | 0         |
| TPBSWG    | Temperature coefficient for PBSWGS/PBSWGD                                    | _     | 0         |
| TRDDR     | Drain-side drift resistance temperature coefficient                          | _     | 0         |
| TRSDR     | Source-side drift resistance temperature coefficient                         | _     | 0         |
| TSILI     | Thickness of the silicide on top of the raised source/drain                  | m     | 1e-08     |
| TSS       | Swing temperature coefficient  | _     | 0         |
| TYPE      | 0: PMOS; 1: NMOS   | _     | 0         |
| U0        | Low-field mobility   | _     | 0.03      |
| UOLT      | Coupled NFIN and length dependence of U0                                     | _     | 0         |
| U0MULT    | Variability in carrier mobility  | _     | 1         |
| U0N1      | NFIN dependence of U0  | _     | 0         |
| U0N1R     | Reverse-mode NFIN dependence of U0   | _     | 0         |
| U0N2      | NFIN dependence of U0  | _     | 100000    |
| U0N2R     | Reverse-mode NFIN dependence of U0   | _     | 0         |
| U0R       | Reverse-mode low-field mobility  | _     | 0         |
| UA        | Phonon/surface roughness scattering parameter                                | _     | 0.3       |
| UA1       | Mobility temperature coefficient for UA                                      | _     | 0.001032  |
| UA1R      | Reverse-mode mobility temperature coefficient for UA                         | _     | 0         |
| UAR       | Reverse-mode phonon/surface roughness scattering parameter                   | _     | 0         |
| UC        | Body effect for mobility degradation parameter -<br>BULKMOD=1 or 2           | _     | 0         |
| UC1       | Mobility temperature coefficient for UC                                      | _     | 5.6e-11   |
| UC1R      | Reverse-mode mobility temperature coefficient for UC                         | _     | 0         |
| UCR       | Reverse-mode body effect for mobility degradation parameter - BULKMOD=1 or 2 | _     | 0         |
| UCS       | Columbic scattering parameter  | _     | 1         |
| UCSTE     | Mobility temperature coefficient   | _     | -0.004775 |
| JD        | Columbic scattering parameter  | _     | 0         |
| UD1       | Mobility temperature coefficient for UC                                      | _     | 0         |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| UD1R      | Reverse-mode mobility temperature coefficient for UD   | _     | 0       |
| UDR       | Reverse-mode columbic scattering parameter   | _     | 0       |
| UP        | Mobility L coefficient   | _     | 0       |
| UPR       | Reverse-mode mobility L coefficient  | _     | 0       |
| UTE       | Mobility temperature coefficient   | _     | 0       |
| UTER      | Reverse-mode for mobility temperature coefficient  | _     | 0       |
| UTL       | Mobility temperature coefficient   | _     | -0.0015 |
| UTLR      | Reverse-mode for mobility temperature coefficient  | _     | 0       |
| VFBSD     | Flatband voltage for S/D region  | V     | 0       |
| VFBSDCV   | Flatband voltage for S/D region for C-V calculations   | V     | 0       |
| VSAT      | Saturation velocity for the saturation region  | _     | 85000   |
| VSAT1     | Velocity saturation parameter for Ion degradation - forward mode                                     | _     | 0       |
| VSAT1N1   | NFIN dependence of VSAT1   | _     | 0       |
| VSAT1N2   | NFIN dependence of VSAT1   | _     | 0       |
| VSAT1R    | Velocity saturation parameter for Ion degradation - reverse mode                                     | _     | 0       |
| VSAT1RN1  | NFIN dependence of VSAT1R  | _     | 0       |
| VSAT1RN2  | NFIN dependence of VSAT1R  | _     | 0       |
| VSATCV    | Velocity saturation parameter for CV   | _     | 0       |
| VSATN1    | NFIN dependence of VSAT  | _     | 0       |
| VSATN2    | NFIN dependence of VSAT  | _     | 100000  |
| VSATR     | Saturation velocity for the saturation region in the reverse mode                                    | _     | 0       |
| VSATRN1   | NFIN dependence of VSATR   | _     | 0       |
| VSATRN2   | NFIN dependence of VSATR   | _     | 0       |
| VTSD      | Bottom drain junction trap-assisted current voltage dependent parameter                              | V     | 0       |
| VTSS      | Bottom source junction trap-assisted current voltage dependent parameter                             | V     | 10      |
| VTSSWD    | Unit length trap-assisted current voltage dependent parameter for sidewall drain junction            | V     | 0       |
| VTSSWGD   | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall drain junction  | V     | 0       |
| VTSSWGS   | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall source junction | V     | 10      |
| VTSSWS    | Unit length trap-assisted current voltage dependent parameter for sidewall source junction           | V     | 10      |

Table 2-125. BSIM-CMG FINFET v110.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| W_UFCM    | Effective channel width for the unified Model                                | m     | 1       |
| WR        | W dependence parameter of S/D extension resistance                           | _     | 1       |
| WTH0      | Width dependence coefficient for Rth and Cth                                 | m     | 0       |
| XJBVD     | Fitting parameter for drain diode breakdown current                          | _     | 0       |
| XJBVS     | Fitting parameter for source diode breakdown current                         | _     | 1       |
| XL        | L offset for channel length due to mask/etch effect                          | m     | 0       |
| XRCRG1    | Parameter for non-quasistatic gate resistance<br>(NQSMOD = 1) and NQSMOD = 2 | _     | 12      |
| XRCRG2    | Parameter for non-quasistatic gate resistance (NQSMOD = 1) and NQSMOD = 2    | _     | 1       |
| XTID      | Drain junction current temperature exponent                                  | _     | 0       |
| XTIS      | Source junction current temperature exponent                                 | _     | 3       |
| XTSD      | Power dependence of JTSD on temperature                                      | _     | 0       |
| XTSS      | Power dependence of JTSS on temperature                                      | _     | 0.02    |
| XTSSWD    | Power dependence of JTSSWD on temperature                                    | _     | 0       |
| XTSSWGD   | Power dependence of JTSSWGD on temperature                                   | _     | 0       |
| XTSSWGS   | Power dependence of JTSSWGS on temperature                                   | _     | 0.02    |
| XTSSWS    | Power dependence of JTSSWS on temperature                                    | _     | 0.02    |

Table 2-126. MOSFET level 110 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WEFF      | WEFF        | -     | none    |
| LEFF      | LEFF        | -     | none    |
| WEFFCV    | WEFFCV      | -     | none    |
| LEFFCV    | LEFFCV      | -     | none    |
| IDS       | IDS         | -     | none    |
| IDEFF     | IDEFF       | _     | none    |
| ISEFF     | ISEFF       | -     | none    |
| IGTOT     | IGTOT       | -     | none    |
| IDSGEN    | IDSGEN      | =     | none    |
| III       | III         | =     | none    |
| IGS       | IGS         | -     | none    |
| IGD       | IGD         | -     | none    |
| IGCS      | IGCS        | -     | none    |
| IGCD      | IGCD        | -     | none    |
| IGBS      | IGBS        | -     | none    |
| ·         |             | ·     |         |

Table 2-126. MOSFET level 110 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| IGBD      | IGBD        | -     | none    |
| IGIDL     | IGIDL       | _     | none    |
| IGISL     | IGISL       | _     | none    |
| IJSB      | IJSB        | _     | none    |
| IJDB      | IJDB        | _     | none    |
| ISUB      | ISUB        | _     | none    |
| ВЕТА      | BETA        | _     | none    |
| VTH       | VTH         | _     | none    |
| VDSSAT    | VDSSAT      | -     | none    |
| VFB       | VFB         | -     | none    |
| GM        | GM          | -     | none    |
| GDS       | GDS         | -     | none    |
| GMBS      | GMBS        | _     | none    |
| QGI       | QGI         | -     | none    |
| QDI       | QDI         | _     | none    |
| QSI       | QSI         | _     | none    |
| QBI       | QBI         | _     | none    |
| QG        | QG          | _     | none    |
| QD        | QD          | _     | none    |
| QS        | QS          | _     | none    |
| QB        | QB          | _     | none    |
| CGGI      | CGGI        | _     | none    |
| CGSI      | CGSI        | _     | none    |
| CGDI      | CGDI        | _     | none    |
| CGEI      | CGEI        | _     | none    |
| CDGI      | CDGI        | _     | none    |
| CDDI      | CDDI        | _     | none    |
| CDSI      | CDSI        | _     | none    |
| CDEI      | CDEI        | _     | none    |
| CSGI      | CSGI        | _     | none    |
| CSDI      | CSDI        | _     | none    |
| CSSI      | CSSI        | _     | none    |
| CSEI      | CSEI        | _     | none    |
| CEGI      | CEGI        | -     | none    |
| CEDI      | CEDI        | -     | none    |
| CESI      | CESI        | _     | none    |

Table 2-126. MOSFET level 110 Output Variables

| Danamatan  | Description |       | Dofoult |
|------------|-------------|-------|---------|
| Parameter  | Description | Units | Default |
| CEEI       | CEEI        | _     | none    |
| CGG        | CGG         | _     | none    |
| CGS        | CGS         |       | none    |
| CGD        | CGD         |       | none    |
| CGE        | CGE         |       | none    |
| CDG        | CDG         | _     | none    |
| CDD        | CDD         |       | none    |
| CDS        | CDS         | _     | none    |
| CDE        | CDE         |       | none    |
| CSG        | CSG         | _     | none    |
| CSD        | CSD         | _     | none    |
| CSS        | CSS         | _     | none    |
| CSE        | CSE         | _     | none    |
| CEG        | CEG         | -     | none    |
| CED        | CED         | _     | none    |
| CES        | CES         | _     | none    |
| CEE        | CEE         | _     | none    |
| CGSEXT     | CGSEXT      | _     | none    |
| CGDEXT     | CGDEXT      | _     | none    |
| CGBOV      | CGBOV       | _     | none    |
| CJST       | CJST        | _     | none    |
| CJDT       | CJDT        | _     | none    |
| RSGEO      | RSGEO       | _     | none    |
| RDGEO      | RDGEO       | _     | none    |
| CFGEO      | CFGEO       | _     | none    |
| T_TOTAL_K  | T_TOTAL_K   | _     | none    |
| T_TOTAL_C  | T_TOTAL_C   | -     | none    |
| T_DELTA_SH | T_DELTA_SH  | _     | none    |
| IGBACC     | IGBACC      | _     | none    |
| IGBINV     | IGBINV      | _     | none    |
| DIDSDVG    | DIDSDVG     | _     | none    |
| DIDSDVS    | DIDSDVS     | _     | none    |
| DIDSDVD    | DIDSDVD     | _     | none    |
| DIGSDVG    | DIGSDVG     | _     | none    |
| DIGSDVS    | DIGSDVS     | _     | none    |
| DIGSDVD    | DIGSDVD     | _     | none    |
|            |             |       |         |

Table 2-126. MOSFET level 110 Output Variables

| Parameter  | Description          | Units | Default |
|------------|----------------------|-------|---------|
| DIGDDVG    | DIGDDVG              | _     | none    |
| DIGDDVS    | DIGDDVS              | _     | none    |
| DIGDDVD    | DIGDDVD              | _     | none    |
| DIIIDVG    | DIIIDVG              | _     | none    |
| DIIIDVS    | DIIIDVS              | _     | none    |
| DIIIDVD    | DIIIDVD              | _     | none    |
| DIGIDLDVG  | DIGIDLDVG            | _     | none    |
| DIGIDLDVS  | DIGIDLDVS            | _     | none    |
| DIGIDLDVD  | DIGIDLDVD            | _     | none    |
| DIGISLDVG  | DIGISLDVG            | _     | none    |
| DIGISLDVS  | DIGISLDVS            | _     | none    |
| DIGISLDVD  | DIGISLDVD            | _     | none    |
| CGT        | CGT                  | _     | none    |
| CST        | CST                  | _     | none    |
| CDT        | CDT                  | _     | none    |
| DIDSDVTH   | DIDSDVTH             | _     | none    |
| DIGSDVTH   | DIGSDVTH             | _     | none    |
| DIGDDVTH   | DIGDDVTH             | _     | none    |
| DIIIDVTH   | DIIIDVTH             | _     | none    |
| DIGIDLDVTH | DIGIDLDVTH           | _     | none    |
| DIGISLDVTH | DIGISLDVTH           | _     | none    |
| DITHDVTH   | DITHDVTH             | _     | none    |
| ITH        | ITH                  | _     | none    |
| DITHDVG    | DITHDVG              | _     | none    |
| DITHDVS    | DITHDVS              | _     | none    |
| DITHDVD    | DITHDVD              | _     | none    |
| VDSAT      | Synonym for VDSSAT   |       | none    |
| VDS        | Drain-source voltage |       | none    |
| VGS        | Gate-source voltage  |       | none    |
| VBS        | Bulk-source voltage  | _     | none    |

## 2.3.20.14. Level 107 and 108 MOSFET Tables (BSIM CMG versions 107.0.0 and 108.0.0)

Xyce includes the legacy BSIM CMG Common Multi-gate model versions 107 and 108. These models have been superceded by the level 110 version, but has been retained for backward compatibility with previous versions of Xyce and older model cards and PDKs. The code in Xyce was generated from the BSIM group's Verilog-A input using the default "ifdef" lines provided, and therefore supports only the

subset of BSIM CMG features those defaults enable. Instance and model parameters for the BSIM CMG model are given in tables 2-127, 2-128, 2-130, and 2-131. Details of the model are documented in the BSIM-CMG technical report[31], available from the BSIM web site at

http://bsim.berkeley.edu/models/bsimcmg/.

Note that the TNOIMOD=1 option of BSIM-CMG 108 is not supported in Xyce, as it uses features of Verilog-A that are not supported in our Verilog-A compiler. This noise model was added in version 108 and removed in version 109. The TNOIMOD=2 option of BSIM-CMG 108 is the same as the TNOIMOD=1 option of BSIM-CMG 110.

Table 2-127. BSIM-CMG FINFET v107.0.0 Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| ADEJ      | Drain junction area (BULKMOD=1)                               | _     | 0       |
| ADEO      | Drain to substrate overlap area through oxide                 | _     | 0       |
| ASEJ      | Source junction area (BULKMOD=1)                              | _     | 0       |
| ASEO      | Source to substrate overlap area through oxide                | _     | 0       |
| CDSP      | Constant drain-to-source fringe capacitance (All CGEOMOD)     | _     | 0       |
| CGDP      | Constant gate-to-drain fringe capacitance (CGEOMOD=1)         | _     | 0       |
| CGSP      | Constant gate-to-source fringe capacitance (CGEOMOD=1)        | _     | 0       |
| COVD      | Constant g/d overlap capacitance (CGEOMOD=1)                  | _     | 0       |
| COVS      | Constant g/s overlap capacitance (CGEOMOD=1)                  | _     | 0       |
| D         | Diameter of the cylinder (GEOMOD=3)                           | _     | 4e-08   |
| FPITCH    | Fin pitch   | _     | 8e-08   |
| L         | Designed Gate Length  | _     | 3e-08   |
| LRSD      | Length of the source/drain                                    | _     | 0       |
| NFIN      | Number of fins per finger (real number enables optimization)  | _     | 1       |
| NGCON     | number of gate contact (1 or 2 sided)                         | _     | 1       |
| NRD       | Number of source diffusion squares                            | _     | 0       |
| NRS       | Number of source diffusion squares                            | _     | 0       |
| PDEJ      | Drain to substrate PN junction perimeter (BULKMOD=1)          | _     | 0       |
| PDEO      | Perimeter of drain to substrate overlap region through oxide  | _     | 0       |
| PSEJ      | Source to substrate PN junction perimeter (BULKMOD=1)         | _     | 0       |
| PSEO      | Perimeter of source to substrate overlap region through oxide | -     | 0       |
| TFIN      | Body (Fin) thickness  | _     | 1.5e-08 |
|           |   |       |         |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units    | Default   |
|-----------|---|----------|-----------|
| A1        | Non-saturation effect parameter for strong inversion region   | _        | 0         |
| A11       | Temperature dependence of A1                                  | _        | 0         |
| A2        | Non-saturation effect parameter for moderate inversion region | _        | 0         |
| A21       | Temperature dependence of A2                                  | _        | 0         |
| ADEJ      | Drain junction area (BULKMOD=1)                               | _        | 0         |
| ADEO      | Drain to substrate overlap area through oxide                 | _        | 0         |
| AEU       |   | _        | 0         |
| AGIDL     | pre-exponential coeff. for GIDL in mho                        | _        | 0         |
| AGISL     | pre-exponential coeff. for GISL in mho                        | _        | 6.055e-12 |
| AIGBACC   | parameter for Igb in accumulation                             | _        | 0.0136    |
| AIGBACC1  | parameter for Igb in accumulation                             | _        | 0         |
| AIGBINV   | parameter for Igb in inversion                                | _        | 0.0111    |
| AIGBINV1  | parameter for Igb in inversion                                | _        | 0         |
| AIGC      | parameter for Igc in inversion                                | _        | 0.0136    |
| AIGC1     | parameter for Igc in inversion                                | _        | 0         |
| AIGD      | parameter for Igd in inversion                                | _        | 0         |
| AIGD1     | parameter for Igd in inversion                                | _        | 0         |
| AIGEN     | Thermal Generation Current Parameter                          | _        | 0         |
| AIGS      | parameter for Igs in inversion                                | _        | 0.0136    |
| AIGS1     | parameter for Igs in inversion                                | _        | 0         |
| ALPHA0    | first parameter of Iii  | m/V      | 0         |
| ALPHA01   | Temperature dependence of ALPHA0, m/V/degrees                 | _        | 0         |
| ALPHA1    | L scaling parameter of Iii                                    | $V^{-1}$ | 0         |
| ALPHA11   | Temperature dependence ALPHA1, 1/V/degree                     | _        | 0         |
| ALPHAIIO  | first parameter of Iii for IIMOD=2, m/V                       | _        | 0         |
| ALPHAII01 | Temperature dependence of ALPHAII0, m/V/degrees               | _        | 0         |
| ALPHAII1  | L scaling parameter of Iii for IIMOD=2                        | $V^{-1}$ | 0         |
| ALPHAII11 | Temperature dependence of ALPHAII1, 1/V/degrees               | _        | 0         |
| AMEXP     |   | _        | 0         |
| AMEXPR    |   | _        | 0         |
| APCLM     |   | _        | 0         |
| APSAT     |   | _        | 0         |
| APSATCV   |   | _        | 0         |
| APTWG     |   | _        | 0         |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units    | Default  |
|-----------|---|----------|----------|
| AQMTCEN   | Parameter for Geometric dependence of Tcen on R/TFIN/HFIN | -        | 0        |
| ARDSW     |   | _        | 0        |
| ARDW      |   | _        | 0        |
| ARSDEND   |   | _        | 0        |
| ARSW      |   | _        | 0        |
| ASEJ      | Source junction area (BULKMOD=1)                          | _        | 0        |
| ASEO      | Source to substrate overlap area through oxide            | _        | 0        |
| ASILIEND  |   | _        | 0        |
| ASYMMOD   | Asymmetric model selector                                 | _        | 0        |
| AT        |   | _        | -0.00156 |
| AUA       |   | _        | 0        |
| AUD       |   | _        | 0        |
| AVSAT     |   | _        | 0        |
| AVSAT1    |   | _        | 0        |
| AVSATCV   |   | _        | 0        |
| BETA0     | Vds dependent parameter of Iii                            | $V^{-1}$ | 0        |
| BETAII0   | Vds dependent parameter of Iii                            | $V^{-1}$ | 0        |
| BETAII1   | Vds dependent parameter of Iii                            | _        | 0        |
| BETAII2   | Vds dependent parameter of Iii, V                         | _        | 0.1      |
| BEU       |   | _        | 1e-07    |
| BG0SUB    | Band gap of substrate at 300.15K, eV                      | _        | 1.12     |
| BGIDL     | exponential coeff. for GIDL                               | V/m      | 0        |
| BGISL     | exponential coeff. for GISL                               | V/m      | 3e+08    |
| BIGBACC   | parameter for Igb in accumulation                         | _        | 0.00171  |
| BIGBINV   | parameter for Igb in inversion                            | _        | 0.000949 |
| BIGC      | parameter for Igc in inversion                            | _        | 0.00171  |
| BIGD      | parameter for Igd in inversion                            | _        | 0        |
| BIGEN     | Thermal Generation Current Parameter                      | _        | 0        |
| BIGS      | parameter for Igs in inversion                            | _        | 0.00171  |
| BMEXP     |   | _        | 1        |
| BMEXPR    |   | _        | 0        |
| BPCLM     |   | _        | 1e-07    |
| BPSAT     |   | _        | 1        |
| BPSATCV   |   | _        | 0        |
| BPTWG     |   | _        | 1e-07    |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| BQMTCEN   | Parameter for Geometric dependence of Tcen on R/TFIN/HFIN                  | _     | 1.2e-08 |
| BRDSW     |  | _     | 1e-07   |
| BRDW      |  | _     | 1e-07   |
| BRSW      |  | _     | 1e-07   |
| BUA       |  | _     | 1e-07   |
| BUD       |  | _     | 5e-08   |
| BULKMOD   | Bulk model   | _     | 0       |
| BVD       | Drain diode breakdown voltage  | _     | 0       |
| BVS       | Source diode breakdown voltage   | _     | 10      |
| BVSAT     |  | _     | 1e-07   |
| BVSAT1    |  | _     | 0       |
| BVSATCV   |  | _     | 0       |
| CAPMOD    | Accumulation region capacitance model selector                             | _     | 0       |
| CDSC      | coupling capacitance between S/D and channel                               | _     | 0.007   |
| CDSCD     | drain-bias sensitivity of CDSC   | _     | 0.007   |
| CDSCDN1   | NFIN dependence of CDSCD   | _     | 0       |
| CDSCDN2   | NFIN dependence of CDSCD   | _     | 100000  |
| CDSCDR    | Reverse-mode drain-bais sensitivity of CDSC (Experimental)                 | _     | 0       |
| CDSCDRN1  | NFIN dependence of CDSCD   | _     | 0       |
| CDSCDRN2  | NFIN dependence of CDSCD   | _     | 0       |
| CDSCN1    | NFIN dependence of CDSC  | _     | 0       |
| CDSCN2    | NFIN dependence of CDSC  | _     | 100000  |
| CDSP      | Constant drain-to-source fringe capacitance (All CGEOMOD)                  | _     | 0       |
| CFD       | Outer Fringe Cap (drain side)  | _     | 0       |
| CFS       | Outer Fringe Cap (source side)   | _     | 2.5e-11 |
| CGBL      | Bias dependent component of Gate to substrate overlap cap                  | -     | 0       |
| CGBN      | Gate to substrate overlap cap per unit channel length per fin per finger   | _     | 0       |
| CGBO      | Gate to substrate overlap cap per unit channel length per finger per NGCON | _     | 0       |
| CGDL      |  | _     | 0       |
| CGDO      | Non LDD region drain-gate overlap capacitance per unit channel width       | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| CGDP      | Constant gate-to-drain fringe capacitance (CGEOMOD=1)                               | _     | 0       |
| CGE01SW   |   | _     | 0       |
| CGEOA     | Fitting parameter for CGEOMOD=2   | _     | 1       |
| CGEOB     | Fitting parameter for CGEOMOD=2   | _     | 0       |
| CGEOC     | Fitting parameter for CGEOMOD=2   | _     | 0       |
| CGEOD     | Fitting parameter for CGEOMOD=2   | _     | 0       |
| CGEOE     | Fitting parameter for CGEOMOD=2   | _     | 1       |
| CGEOMOD   | parasitic capacitance model selector  | _     | 0       |
| CGIDL     | parameter for body-effect of GIDL   | $V^3$ | 0       |
| CGISL     | parameter for body-effect of GISL   | $V^3$ | 0.5     |
| CGSL      |   | _     | 0       |
| CGSO      | Non LDD region source-gate overlap capacitance per unit channel width               | _     | 0       |
| CGSP      | Constant gate-to-source fringe capacitance (CGEOMOD=1)                              | _     | 0       |
| CHARGEWF  | Average Channel Charge Weighting Factor,<br>+1:source-side, 0:middle, -1:drain-side | _     | 0       |
| CIGBACC   | parameter for Igb in accumulation   | _     | 0.075   |
| CIGBINV   | parameter for Igb in inversion  | _     | 0.006   |
| CIGC      | parameter for Igc in inversion  | _     | 0.075   |
| CIGD      | parameter for Igd in inversion  | _     | 0       |
| CIGS      | parameter for Igs in inversion  | _     | 0.075   |
| CIT       | parameter for interface trap  | _     | 0       |
| CJD       | Unit area drain-side junction capacitance at zero bias                              | _     | 0       |
| CJS       | Unit area source-side junction capacitance at zero bias                             | _     | 0.0005  |
| CJSWD     | Unit length drain-side sidewall junction capacitance at zero bias                   | _     | 0       |
| CJSWGD    | Unit length drain-side gate sidewall junction capacitance at zero bias              | _     | 0       |
| CJSWGS    | Unit length source-side gate sidewall junction capacitance at zero bias             | _     | 0       |
| CJSWS     | Unit length source-side sidewall junction capacitance at zero bias                  | _     | 5e-10   |
| СКАРРАВ   |   | _     | 0.6     |
| CKAPPAD   |   | _     | 0       |
| CKAPPAS   |   | _     | 0.6     |
| COREMOD   | Surface potential algorithm   | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| COVD        | Constant g/d overlap capacitance (CGEOMOD=1)                                | _     | 0       |
| COVS        | Constant g/s overlap capacitance (CGEOMOD=1)                                | _     | 0       |
| CRATIO      |   | _     | 0.5     |
| CSDESW      | Coefficient for source/drain to substrate sidewall cap                      | _     | 0       |
| CTH0        | Thermal capacitance   | _     | 1e-05   |
| )           | Diameter of the cylinder (GEOMOD=3)   | _     | 4e-08   |
| DELTAPRSD   |   | _     | 0       |
| DELTAVSAT   |   | _     | 1       |
| DELTAVSATCV |   | _     | 0       |
| DELTAW      | change of effective width due to shape of fin/cylinder                      | _     | 0       |
| DELTAWCV    | CV change of effective width due to shape of fin/cylinder                   | _     | 0       |
| DELVFBACC   | Change in Flatband Voltage; Vfb_accumulation-Vfb_inversion                  | _     | 0       |
| DELVTRAND   | Variability in Vth  | _     | 0       |
| DEVTYPE     |   | _     | 1       |
| DLBIN       | Delta L for Binning   | _     | 0       |
| DLC         | Delta L for C-V model   | _     | 0       |
| DLCACC      | Delta L for C-V model in accumulation region (CAPMOD=1, BULKMOD=1)          |       | 0       |
| DLCIGD      | Delta L for Igd model   | _     | 0       |
| DLCIGS      | Delta L for Igs model   | _     | 0       |
| DROUT       |   | _     | 1.06    |
| DSUB        | DIBL exponent coefficient   | _     | 1.06    |
| OTEMP       | Variability in Device Temperature   | _     | 0       |
| OTVO        | SCE coefficient   | _     | 0       |
| DVT1        | SCE exponent coefficient, after binning should be in (0:inf)                | _     | 0.6     |
| DVT1SS      | Subthreshold Swing exponent coefficient, after binning should be in (0:inf) | -     | 0       |
| OVTP0       | Coefficient for Drain-Induced Vth Shift (DITS)                              | _     | 0       |
| OVTP1       | DITS exponent coefficient   | _     | 0       |
| OVTSHIFT    | Vth shift handle  | _     | 0       |
| EASUB       | Electron affinity of substrate, eV  | _     | 4.05    |
| ΣF          |   | _     | 1       |
| EGIDL       | band bending parameter for GIDL   | V     | 0       |
| EGISL       | band bending parameter for GISL   | V     | 0.2     |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| EIGBINV   | parameter for Igb in inversion   | _     | 1.1     |
| EM        |  | _     | 4.1e+07 |
| EMOBT     |  | _     | 0       |
| EOT       | equivalent oxide thickness in meters   | _     | 1e-09   |
| EOTACC    | equivalent oxide thickness for accumulation region in meters                               | m     | 0       |
| EOTBOX    | equivalent oxide thickness of the buried oxide (SOI FinFET) or STI (bulk FinFET) in meters | -     | 1.4e-07 |
| EPSROX    | Relative dielectric constant of the gate dielectric  | _     | 3.9     |
| EPSRSP    | Relative dielectric constant of the spacer   | _     | 3.9     |
| EPSRSUB   | Relative dielectric constant of the channel material                                       | _     | 11.9    |
| ESATII    | Saturation channel E-Field for Iii   | V/m   | 1e+07   |
| ETA0      | DIBL coefficient   |       | 0.6     |
| ETA0N1    | NFIN dependence of ETA0  | _     | 0       |
| ETA0N2    | NFIN dependence of ETA0  |       | 100000  |
| ETA0R     | Reverse-mode DIBL coefficient (Experimental)   | _     | 0       |
| ETAMOB    |  | _     | 2       |
| ETAQM     | Bulk charge coefficient for Tcen   | _     | 0.54    |
| EU        |  | _     | 2.5     |
| FECH      | End-channel factor, for different orientation/shape  | _     | 1       |
| FECHCV    | CV end-channel factor, for different orientaion/shape                                      | _     | 1       |
| FPITCH    | Fin pitch  | -     | 8e-08   |
| GEOMOD    | Geometry mode selector   | _     | 1       |
| GIDLMOD   | GIDL/GISL current switcher   | _     | 0       |
| HEPI      | Height of the raised source/drain on top of the fin  | _     | 1e-08   |
| HFIN      | Fin height in meters   | _     | 3e-08   |
| IDS0MULT  | Variability in Drain current for misc. reasons   | _     | 1       |
| IGBMOD    | model selector for Igb   | _     | 0       |
| IGCMOD    | model selector for Igc, Igs, and Igd   | _     | 0       |
| IGT       | Gate Current Temperature Dependence  | _     | 2.5     |
| IIMOD     | Impact ionization model switch   | _     | 0       |
| IIT       | Impact Ionization Temperature Dependence, IIMOD=1  |       | -0.5    |
| IJTHDFWD  | Forward drain diode breakdown limiting current   | _     | 0       |
| IJTHDREV  | Reverse drain diode breakdown limiting current   | _     | 0       |
| IJTHSFWD  | Forward source diode breakdown limiting current  | _     | 0.1     |
| IJTHSREV  | Reverse source diode breakdown limiting current  | _     | 0.1     |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| IMIN      | Parameter for Vgs Clamping for inversion region calc. in accumulation                     | _     | 1e-15   |
| JSD       | Bottom drain junction reverse saturation current density                                  | _     | 0       |
| JSS       | Bottom source junction reverse saturation current density                                 | _     | 0.0001  |
| JSWD      | Unit length reverse saturation current for sidewall drain junction                        | _     | 0       |
| JSWGD     | Unit length reverse saturation current for gate-edge sidewall drain junction              | _     | 0       |
| JSWGS     | Unit length reverse saturation current for gate-edge sidewall source junction             | _     | 0       |
| JSWS      | Unit length reverse saturation current for sidewall source junction                       | _     | 0       |
| JTSD      | Bottom drain junction trap-assisted saturation current density                            | -     | 0       |
| JTSS      | Bottom source junction trap-assisted saturation current density                           | _     | 0       |
| JTSSWD    | Unit length trap-assisted saturation current for sidewall drain junction                  | _     | 0       |
| JTSSWGD   | Unit length trap-assisted saturation current for gate-edge sidewall drain junction        | _     | 0       |
| JTSSWGS   | Unit length trap-assisted saturation current for gate-edge sidewall source junction       | _     | 0       |
| JTSSWS    | Unit length trap-assisted saturation current for sidewall source junction                 | _     | 0       |
| JTWEFF    | Trap assisted tunneling current width dependence  | _     | 0       |
| K0        | Lateral NUD voltage parameter, V  | _     | 0       |
| K01       | Temperature dependence of lateral NUD voltage parameter, V/K                              | _     | 0       |
| KOSI      | Correction factor for strong inversion, used in Mnud, after binnig should be from (0:inf) | _     | 1       |
| K0SI1     | Temperature dependence of K0SI, 1/K   | _     | 0       |
| K1        | Body effect coefficient for sub-threshold region  | _     | 0       |
| K11       | Temperature dependence of K1  | _     | 0       |
| K1RSCE    | K1 for reverse short channel effect calculation   | _     | 0       |
| K1SAT     | Correction factor for K1 in saturation (high Vds)   | _     | 0       |
| K1SAT1    | Temperature dependence of K1SAT1  | _     | 0       |
| K1SI      | Correction factor for strong inversion, used in Mob                                       | _     | 0       |
| K1SI1     | Temperature dependence of K1SI, 1/K   | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description                         | Units | Default |
|-----------|-------------------------------------|-------|---------|
| KSATIV    |                                     | -     | 1       |
| KT1       | Vth Temperature Coefficient (V)     | _     | 0       |
| KT1L      | Vth Temperature L Coefficient (m-V) | _     | 0       |
| L         | Designed Gate Length                | _     | 3e-08   |
| LA1       |                                     | _     | 0       |
| LA11      |                                     | _     | 0       |
| LA2       |                                     | _     | 0       |
| LA21      |                                     | _     | 0       |
| LAGIDL    |                                     | _     | 0       |
| LAGISL    |                                     | _     | 0       |
| LAIGBACC  |                                     | _     | 0       |
| LAIGBACC1 |                                     | _     | 0       |
| LAIGBINV  |                                     | _     | 0       |
| LAIGBINV1 |                                     | _     | 0       |
| LAIGC     |                                     | _     | 0       |
| LAIGC1    |                                     | _     | 0       |
| LAIGD     |                                     | _     | 0       |
| LAIGD1    |                                     | _     | 0       |
| LAIGEN    |                                     | _     | 0       |
| LAIGS     |                                     | _     | 0       |
| LAIGS1    |                                     | _     | 0       |
| LALPHA0   |                                     | _     | 0       |
| LALPHA1   |                                     | _     | 0       |
| LALPHAIIO |                                     | _     | 0       |
| LALPHAII1 |                                     | _     | 0       |
| LAT       |                                     | _     | 0       |
| LBETA0    |                                     | _     | 0       |
| LBETAIIO  |                                     | _     | 0       |
| LBETAII1  |                                     | _     | 0       |
| LBETAII2  |                                     | _     | 0       |
| LBGIDL    |                                     | _     | 0       |
| LBGISL    |                                     | _     | 0       |
| LBIGBACC  |                                     | -     | 0       |
| LBIGBINV  |                                     | _     | 0       |
| LBIGC     |                                     | _     | 0       |
| LBIGD     |                                     | _     | 0       |
|           |                                     |       |         |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter    | Description | Units | Default |
|--------------|-------------|-------|---------|
| LBIGEN       |             | _     | 0       |
| LBIGS        |             | _     | 0       |
| LCDSC        |             | _     | 0       |
| LCDSCD       |             | _     | 0       |
| LCDSCDR      |             | _     | 0       |
| LCFD         |             | _     | 0       |
| LCFS         |             | _     | 0       |
| LCGBL        |             | _     | 0       |
| LCGDL        |             | _     | 0       |
| LCGIDL       |             | _     | 0       |
| LCGISL       |             | _     | 0       |
| LCGSL        |             | _     | 0       |
| LCIGBACC     |             | _     | 0       |
| LCIGBINV     |             | _     | 0       |
| LCIGC        |             | _     | 0       |
| LCIGD        |             | _     | 0       |
| LCIGS        |             | _     | 0       |
| LCIT         |             | _     | 0       |
| LCKAPPAB     |             | _     | 0       |
| LCKAPPAD     |             | _     | 0       |
| LCKAPPAS     |             | _     | 0       |
| LCOVD        |             | _     | 0       |
| LCOVS        |             | _     | 0       |
| LDELTAVSAT   |             | _     | 0       |
| LDELTAVSATCV |             | _     | 0       |
| LDROUT       |             | _     | 0       |
| LDSUB        |             | _     | 0       |
| LDVT0        |             | _     | 0       |
| LDVT1        |             | _     | 0       |
| LDVT1SS      |             | _     | 0       |
| LDVTB        |             | -     | 0       |
| LDVTSHIFT    |             | _     | 0       |
| LEGIDL       |             | _     | 0       |
| LEGISL       |             | _     | 0       |
| LEIGBINV     |             | -     | 0       |
| LEMOBT       |             | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LESATII   |  | _     | 0       |
| LETA0     |  | _     | 0       |
| LETA0R    |  | _     | 0       |
| LETAMOB   |  | _     | 0       |
| LEU       |  | _     | 0       |
| LIGT      |  | _     | 0       |
| LII       | Channel length dependent parameter of Iii            | Vm    | 5e-10   |
| LIIT      |  | _     | 0       |
| LINT      | Length reduction parameter (dopant diffusion effect) | _     | 0       |
| LINTIGEN  | Lint for Thermal Generation Current                  | _     | 0       |
| LINTNOI   |  | _     | 0       |
| LK0       |  | _     | 0       |
| LK01      |  | _     | 0       |
| LKOSI     |  | _     | 0       |
| LK0SI1    |  | _     | 0       |
| LK1       |  | _     | 0       |
| LK11      |  | _     | 0       |
| LK1RSCE   |  | _     | 0       |
| LK1SAT    |  | _     | 0       |
| LK1SAT1   |  | _     | 0       |
| LK1SI     |  | _     | 0       |
| LK1SI1    |  | _     | 0       |
| LKSATIV   |  | _     | 0       |
| LKT1      |  | _     | 0       |
| LL        | Length reduction parameter (dopant diffusion effect) | _     | 0       |
| LLC       | Length reduction parameter (dopant diffusion effect) | _     | 0       |
| LLII      |  | _     | 0       |
| LLN       | Length reduction parameter (dopant diffusion effect) | _     | 1       |
| LLPE0     |  | _     | 0       |
| LLPEB     |  | _     | 0       |
| LMEXP     |  | _     | 0       |
| LMEXPR    |  | _     | 0       |
| LNBODY    |  | _     | 0       |
| LNGATE    |  | _     | 0       |
| LNIGBACC  |  | _     | 0       |
| LNIGBINV  |  | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter  | Description                                     | Units | Default |
|------------|---|-------|---------|
| LNTGEN     |   | _     | 0       |
| LNTOX      |   | _     | 0       |
| LPA        |   | _     | 1       |
| LPCLM      |   | _     | 0       |
| LPCLMCV    |   | _     | 0       |
| LPCLMG     |   | _     | 0       |
| LPDIBL1    |   | _     | 0       |
| LPDIBL1R   |   | -     | 0       |
| LPDIBL2    |   | -     | 0       |
| LPE0       | Equivalent length of pocket region at zero bias | -     | 5e-09   |
| LPGIDL     |   | _     | 0       |
| LPGISL     |   | _     | 0       |
| LPHIBE     |   | _     | 0       |
| LPHIG      |   | _     | 0       |
| LPHIN      |   | _     | 0       |
| LPIGCD     |   | _     | 0       |
| LPOXEDGE   |   | _     | 0       |
| LPRT       |   | _     | 0       |
| LPRWGD     |   | _     | 0       |
| LPRWGS     |   | _     | 0       |
| LPSAT      |   | _     | 0       |
| LPSATCV    |   | _     | 0       |
| LPTWG      |   | _     | 0       |
| LPTWGR     |   | _     | 0       |
| LPTWGT     |   | _     | 0       |
| LPVAG      |   | _     | 0       |
| LQMFACTOR  |   | _     | 0       |
| LQMTCENCV  |   | _     | 0       |
| LQMTCENCVA |   | _     | 0       |
| LQMTCENIV  |   | _     | 0       |
| LRDSW      |   | _     | 0       |
| LRDW       |   | _     | 0       |
| LRSD       | Length of the source/drain                      | _     | 0       |
| LRSW       |   | _     | 0       |
| LSII0      |   | _     | 0       |
| LSII1      |   | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter   | Description  | Units | Default |
|-------------|--|-------|---------|
| LSII2       |  | _     | 0       |
| LSIID       |  | _     | 0       |
| LSP         |  | _     | 0       |
| LSTTHETASAT |  | _     | 0       |
| LTGIDL      |  | _     | 0       |
| LTII        |  | _     | 0       |
| LTSS        |  | _     | 0       |
| LU0         |  | _     | 0       |
| LUA         |  | _     | 0       |
| LUA1        |  | _     | 0       |
| LUC         |  | _     | 0       |
| LUC1        |  | _     | 0       |
| LUCS        |  | _     | 0       |
| LUCSTE      |  | _     | 0       |
| LUD         |  | _     | 0       |
| LUD1        |  | _     | 0       |
| LUP         |  | _     | 0       |
| LUTE        |  | _     | 0       |
| LUTL        |  | _     | 0       |
| LVSAT       |  | _     | 0       |
| LVSAT1      |  | _     | 0       |
| LVSAT1R     |  | _     | 0       |
| LVSATCV     |  | _     | 0       |
| LWR         |  | _     | 0       |
| LXRCRG1     |  | _     | 0       |
| LXRCRG2     |  | _     | 0       |
| MEXP        |  | _     | 4       |
| MEXPR       |  | _     | 0       |
| MJD         | Drain bottom junction capacitance grading coefficient                  | _     | 0       |
| MJD2        | Drain bottom two-step second junction capacitance grading coefficient  | _     | 0       |
| MJS         | Source bottom junction capacitance grading coefficient                 | _     | 0.5     |
| MJS2        | Source bottom two-step second junction capacitance grading coefficient | _     | 0.125   |
| MJSWD       | Drain sidewall junction capacitance grading coefficient                | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter Description                           |                                     | Units | Default |
|---|-------------------------------------|-------|---------|
| MJSWD2 Drain sidewall tw<br>grading coefficien  | o-step second junction capacitance  | _     | 0       |
| MJSWGD Drain-side gate si coefficient           | dewall junction capacitance grading | _     | 0       |
| MJSWGD2 Drain-side gate si                      | dewall two-step                     | _     | 0       |
| MJSWGS Source-side gate s<br>grading coefficien | sidewall junction capacitance       | _     | 0       |
| MJSWGS2 Source-side gate s                      | sidewall two-step                   | _     | 0       |
| MJSWS Source sidewall ju coefficient            | unction capacitance grading         | _     | 0.33    |
| MJSWS2 Source sidewall to grading coefficier    | wo-step second junction capacitance | _     | 0.083   |
| NA1   |                                     | _     | 0       |
| NA11  |                                     | _     | 0       |
| NA2   |                                     | _     | 0       |
| NA21  |                                     | _     | 0       |
| NAGIDL  |                                     | -     | 0       |
| NAGISL  |                                     | _     | 0       |
| NAIGBACC  |                                     | _     | 0       |
| NAIGBACC1                                       |                                     | _     | 0       |
| NAIGBINV  |                                     | _     | 0       |
| NAIGBINV1                                       |                                     | _     | 0       |
| NAIGC   |                                     | -     | 0       |
| NAIGC1  |                                     | -     | 0       |
| NAIGD   |                                     | -     | 0       |
| NAIGD1  |                                     | _     | 0       |
| NAIGEN  |                                     |       | 0       |
| NAIGS   |                                     | _     | 0       |
| NAIGS1  |                                     | _     | 0       |
| NALPHA0   |                                     | _     | 0       |
| NALPHA1   |                                     |       | 0       |
| NALPHAIIO                                       |                                     | _     | 0       |
| NALPHAII1                                       |                                     | _     | 0       |
| NAT   |                                     | _     | 0       |
| NBETA0  |                                     | -     | 0       |
| NBETAIIO  |                                     | _     | 0       |
| NBETAII1  |                                     |       | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter    | Description                              | Units | Default  |
|--------------|--|-------|----------|
| NBETAII2     |  | -     | 0        |
| NBGIDL       |  | _     | 0        |
| NBGISL       |  | _     | 0        |
| NBIGBACC     |  | _     | 0        |
| NBIGBINV     |  | -     | 0        |
| NBIGC        |  | _     | 0        |
| NBIGD        |  | _     | 0        |
| NBIGEN       |  | -     | 0        |
| NBIGS        |  | -     | 0        |
| NBODY        | channel (body) doping                    | _     | 1e+22    |
| NBODYN1      | NFIN dependence of channel (body) doping | _     | 0        |
| NBODYN2      | NFIN dependence of channel (body) doping | -     | 100000   |
| NC0SUB       | Conduction band density of states, m-3   | _     | 2.86e+25 |
| NCDSC        |  | -     | 0        |
| NCDSCD       |  | -     | 0        |
| NCDSCDR      |  | -     | 0        |
| NCFD         |  | -     | 0        |
| NCFS         |  | _     | 0        |
| NCGBL        |  | _     | 0        |
| NCGDL        |  | _     | 0        |
| NCGIDL       |  | -     | 0        |
| NCGISL       |  | _     | 0        |
| NCGSL        |  | _     | 0        |
| NCIGBACC     |  | -     | 0        |
| NCIGBINV     |  | _     | 0        |
| NCIGC        |  | _     | 0        |
| NCIGD        |  | _     | 0        |
| NCIGS        |  | _     | 0        |
| NCIT         |  | -     | 0        |
| NCKAPPAB     |  | -     | 0        |
| NCKAPPAD     |  | -     | 0        |
| NCKAPPAS     |  | _     | 0        |
| NCOVD        |  | _     | 0        |
| NCOVS        |  | _     | 0        |
| NDELTAVSAT   |  | _     | 0        |
| NDELTAVSATCV |  | _     | 0        |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| NDROUT    |   | _     | 0       |
| NDSUB     |   | _     | 0       |
| NDVT0     |   | _     | 0       |
| NDVT1     |   | _     | 0       |
| NDVT1SS   |   | _     | 0       |
| NDVTB     |   | _     | 0       |
| NDVTSHIFT |   | _     | 0       |
| NEGIDL    |   | _     | 0       |
| NEGISL    |   | _     | 0       |
| NEIGBINV  |   | _     | 0       |
| NEMOBT    |   | _     | 0       |
| NESATII   |   | _     | 0       |
| NETA0     |   | _     | 0       |
| NETA0R    |   | _     | 0       |
| NETAMOB   |   | _     | 0       |
| NEU       |   | _     | 0       |
| NF        | Number of fingers   | _     | 1       |
| NFIN      | Number of fins per finger (real number enables optimization)        | _     | 1       |
| NGATE     | Parameter for Poly Gate Doping, for metal gate please set NGATE = 0 | _     | 0       |
| NGCON     | number of gate contact (1 or 2 sided)                               | _     | 1       |
| NIOSUB    | Intrinsic carrier constant at 300.15K, m-3                          | _     | 1.1e+16 |
| NIGBACC   | parameter for Igb in accumulation                                   | _     | 1       |
| NIGBINV   | parameter for Igb in inversion                                      | _     | 3       |
| NIGT      |   | _     | 0       |
| NIIT      |   | _     | 0       |
| NJD       | Drain junction emission coefficient                                 | _     | 0       |
| NJS       | Source junction emission coefficient                                | _     | 1       |
| NJTS      | Non-ideality factor for JTSS  | _     | 20      |
| NJTSD     | Non-ideality factor for JTSD  | _     | 0       |
| NJTSSW    | Non-ideality factor for JTSSWS                                      | _     | 20      |
| NJTSSWD   | Non-ideality factor for JTSSWD                                      | _     | 0       |
| NJTSSWG   | Non-ideality factor for JTSSWGS                                     | _     | 20      |
| NJTSSWGD  | Non-ideality factor for JTSSWGD                                     | _     | 0       |
| NK0       |   | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description | Units | Default   |
|-----------|-------------|-------|-----------|
| NK01      |             | -     | 0         |
| NKOSI     |             | _     | 0         |
| NK0SI1    |             | _     | 0         |
| NK1       |             | _     | 0         |
| NK11      |             | -     | 0         |
| NK1RSCE   |             | _     | 0         |
| NK1SAT    |             | _     | 0         |
| NK1SAT1   |             | _     | 0         |
| NK1SI     |             | _     | 0         |
| NK1SI1    |             | _     | 0         |
| NKSATIV   |             | _     | 0         |
| NKT1      |             | _     | 0         |
| NLII      |             | _     | 0         |
| NLPE0     |             | _     | 0         |
| NLPEB     |             | _     | 0         |
| NMEXP     |             | -     | 0         |
| NMEXPR    |             | -     | 0         |
| NNBODY    |             | _     | 0         |
| NNGATE    |             | -     | 0         |
| NNIGBACC  |             | _     | 0         |
| NNIGBINV  |             | _     | 0         |
| NNTGEN    |             | _     | 0         |
| NNTOX     |             | _     | 0         |
| NOIA      |             | _     | 6.25e+39  |
| NOIB      |             | _     | 3.125e+24 |
| NOIC      |             | _     | 8.75e+07  |
| NPCLM     |             | _     | 0         |
| NPCLMCV   |             | -     | 0         |
| NPCLMG    |             | _     | 0         |
| NPDIBL1   |             | _     | 0         |
| NPDIBL1R  |             | -     | 0         |
| NPDIBL2   |             | _     | 0         |
| NPGIDL    |             | _     | 0         |
| NPGISL    |             | _     | 0         |
| NPHIBE    |             | _     | 0         |
| NPHIG     |             | _     | 0         |
|           |             |       |           |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter   | Description  | Units | Default |
|-------------|--|-------|---------|
| NPHIN       |  | _     | 0       |
| NPIGCD      |  | _     | 0       |
| NPOXEDGE    |  | _     | 0       |
| NPRT        |  | _     | 0       |
| NPRWGD      |  | _     | 0       |
| NPRWGS      |  | _     | 0       |
| NPSAT       |  | _     | 0       |
| NPSATCV     |  | _     | 0       |
| NPTWG       |  | _     | 0       |
| NPTWGR      |  | _     | 0       |
| NPTWGT      |  | _     | 0       |
| NPVAG       |  | _     | 0       |
| NQMFACTOR   |  | _     | 0       |
| NQMTCENCV   |  | _     | 0       |
| NQMTCENCVA  |  | _     | 0       |
| NQMTCENIV   |  | _     | 0       |
| NQSMOD      |  | _     | 0       |
| NRD         | Number of source diffusion squares                     | _     | 0       |
| NRDSW       |  | _     | 0       |
| NRDW        |  | _     | 0       |
| NRS         | Number of source diffusion squares                     | _     | 0       |
| NRSW        |  | _     | 0       |
| NSD         | Source/drain active doping concentration in m-3        | _     | 2e+26   |
| NSDE        | Source/drain active doping concentration at Leff edge  | _     | 2e+25   |
| NSEG        | Number of segments for NQSMOD=3 (3,5 and 10 supported) | -     | 4       |
| NSII0       |  | _     | 0       |
| NSII1       |  | _     | 0       |
| NSII2       |  | _     | 0       |
| NSIID       |  | _     | 0       |
| NSTTHETASAT |  | _     | 0       |
| NTGEN       | Thermal Generation Current Parameter                   | _     | 1       |
| NTGIDL      |  | _     | 0       |
| NTII        |  | _     | 0       |
| NTNOI       |  | _     | 1       |
| NTOX        | Exponent for Tox ratio                                 | _     | 1       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| NTSS      |             | -     | 0       |
| NU0       |             | _     | 0       |
| NUA       |             | _     | 0       |
| NUA1      |             | _     | 0       |
| NUC       |             | _     | 0       |
| NUC1      |             | _     | 0       |
| NUCS      |             | _     | 0       |
| NUCSTE    |             | _     | 0       |
| NUD       |             | _     | 0       |
| NUD1      |             | _     | 0       |
| NUP       |             | _     | 0       |
| NUTE      |             | _     | 0       |
| NUTL      |             | _     | 0       |
| NVSAT     |             | _     | 0       |
| NVSAT1    |             | _     | 0       |
| NVSAT1R   |             | _     | 0       |
| NVSATCV   |             | _     | 0       |
| NWR       |             | _     | 0       |
| NXRCRG1   |             | _     | 0       |
| NXRCRG2   |             | _     | 0       |
| PA1       |             | _     | 0       |
| PA11      |             | _     | 0       |
| PA2       |             | _     | 0       |
| PA21      |             | _     | 0       |
| PAGIDL    |             | _     | 0       |
| PAGISL    |             | -     | 0       |
| PAIGBACC  |             | -     | 0       |
| PAIGBACC1 |             | -     | 0       |
| PAIGBINV  |             | -     | 0       |
| PAIGBINV1 |             | _     | 0       |
| PAIGC     |             | -     | 0       |
| PAIGC1    |             | _     | 0       |
| PAIGD     |             | _     | 0       |
| PAIGD1    |             | -     | 0       |
| PAIGEN    |             | -     | 0       |
| PAIGS     |             |       | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PAIGS1    |   | _     | 0       |
| PALPHA0   |   | _     | 0       |
| PALPHA1   |   | _     | 0       |
| PALPHAIIO |   | _     | 0       |
| PALPHAII1 |   | _     | 0       |
| PAT       |   | _     | 0       |
| PBD       | Drain-side bulk junction built-in potential                           | _     | 0       |
| PBETA0    |   | _     | 0       |
| PBETAIIO  |   | _     | 0       |
| PBETAII1  |   | _     | 0       |
| PBETAII2  |   | _     | 0       |
| PBGIDL    |   | _     | 0       |
| PBGISL    |   | _     | 0       |
| PBIGBACC  |   | _     | 0       |
| PBIGBINV  |   | _     | 0       |
| PBIGC     |   | _     | 0       |
| PBIGD     |   | _     | 0       |
| PBIGEN    |   | _     | 0       |
| PBIGS     |   | _     | 0       |
| PBS       | Source-side bulk junction built-in potential                          | _     | 1       |
| PBSWD     | Built-in potential for Drain-side sidewall junction capacitance       | _     | 0       |
| PBSWGD    | Built-in potential for Drain-side gate sidewall junction capacitance  | _     | 0       |
| PBSWGS    | Built-in potential for Source-side gate sidewall junction capacitance | _     | 0       |
| PBSWS     | Built-in potential for Source-side sidewall junction capacitance      | _     | 1       |
| PCDSC     |   | _     | 0       |
| PCDSCD    |   | _     | 0       |
| PCDSCDR   |   | _     | 0       |
| PCFD      |   | _     | 0       |
| PCFS      |   | _     | 0       |
| PCGBL     |   | _     | 0       |
| PCGDL     |   | _     | 0       |
| PCGIDL    |   | _     | 0       |
| PCGISL    |   | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter    | Description  | Units | Default |
|--------------|--|-------|---------|
| PCGSL        |  | _     | 0       |
| PCIGBACC     |  | _     | 0       |
| PCIGBINV     |  | _     | 0       |
| PCIGC        |  | _     | 0       |
| PCIGD        |  | _     | 0       |
| PCIGS        |  | _     | 0       |
| PCIT         |  | _     | 0       |
| РСКАРРАВ     |  | _     | 0       |
| PCKAPPAD     |  | _     | 0       |
| PCKAPPAS     |  | _     | 0       |
| PCLM         |  | _     | 0.013   |
| PCLMCV       | CLM parameter for Short Channel CV                           | _     | 0       |
| PCLMG        |  | _     | 0       |
| PCOVD        |  | _     | 0       |
| PCOVS        |  | _     | 0       |
| PDEJ         | Drain to substrate PN junction perimeter (BULKMOD=1)         | _     | 0       |
| PDELTAVSAT   |  | _     | 0       |
| PDELTAVSATCV |  | _     | 0       |
| PDEO         | Perimeter of drain to substrate overlap region through oxide | _     | 0       |
| PDIBL1       | DIBL Output Conductance parameter - forward mode             | _     | 1.3     |
| PDIBL1R      | DIBL Output Conductance parameter - reverse mode             | _     | 0       |
| PDIBL2       | DIBL Output Conductance parameter                            | _     | 0.0002  |
| PDROUT       |  | _     | 0       |
| PDSUB        |  | _     | 0       |
| PDVT0        |  | _     | 0       |
| PDVT1        |  | _     | 0       |
| PDVT1SS      |  | _     | 0       |
| PDVTB        |  | _     | 0       |
| PDVTSHIFT    |  | _     | 0       |
| PEGIDL       |  | _     | 0       |
| PEGISL       |  | _     | 0       |
| PEIGBINV     |  | _     | 0       |
| PEMOBT       |  | _     | 0       |
| PESATII      |  | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PETA0     |   | _     | 0       |
| PETAOR    |   | _     | 0       |
| PETAMOB   |   | _     | 0       |
| PEU       |   | _     | 0       |
| PGIDL     | parameter for body-bias effect on GIDL                                  | _     | 0       |
| PGISL     | parameter for body-bias effect on GISL                                  | _     | 1       |
| PHIBE     | Body effect voltage parameter, V, after binnig should be from [0.2:1.2] | _     | 0.7     |
| PHIG      | Gate workfunction, eV   | _     | 4.61    |
| PHIGL     | Length dependence of Gate workfunction, eV/m                            | _     | 0       |
| PHIGN1    | NFIN dependence of Gate workfunction                                    | -     | 0       |
| PHIGN2    | NFIN dependence of Gate workfunction                                    | _     | 100000  |
| PHIN      | Nonuniform vertical doping effect on surface potential, V               | _     | 0.05    |
| PIGCD     | parameter for Igc partition   | _     | 1       |
| PIGT      |   | _     | 0       |
| PIIT      |   | _     | 0       |
| PK0       |   | -     | 0       |
| PK01      |   | _     | 0       |
| PK0SI     |   | _     | 0       |
| PK0SI1    |   | _     | 0       |
| PK1       |   | _     | 0       |
| PK11      |   | _     | 0       |
| PK1RSCE   |   | -     | 0       |
| PK1SAT    |   | _     | 0       |
| PK1SAT1   |   | _     | 0       |
| PK1SI     |   | _     | 0       |
| PK1SI1    |   | _     | 0       |
| PKSATIV   |   | _     | 0       |
| PKT1      |   | _     | 0       |
| PLII      |   | _     | 0       |
| PLPE0     |   | _     | 0       |
| PLPEB     |   | _     | 0       |
| PMEXP     |   | _     | 0       |
| PMEXPR    |   | _     | 0       |
| PNBODY    |   | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter  | Description                              | Units | Default |
|------------|--|-------|---------|
| PNGATE     |  | _     | 0       |
| PNIGBACC   |  | _     | 0       |
| PNIGBINV   |  | -     | 0       |
| PNTGEN     |  | _     | 0       |
| PNTOX      |  | -     | 0       |
| POXEDGE    | Factor for the gate edge Tox             | _     | 1       |
| PPCLM      |  | _     | 0       |
| PPCLMCV    |  | -     | 0       |
| PPCLMG     |  | -     | 0       |
| PPDIBL1    |  | -     | 0       |
| PPDIBL1R   |  | -     | 0       |
| PPDIBL2    |  | -     | 0       |
| PPGIDL     |  | -     | 0       |
| PPGISL     |  | -     | 0       |
| PPHIBE     |  | -     | 0       |
| PPHIG      |  | -     | 0       |
| PPHIN      |  | -     | 0       |
| PPIGCD     |  | -     | 0       |
| PPOXEDGE   |  | -     | 0       |
| PPRT       |  | _     | 0       |
| PPRWGD     |  | _     | 0       |
| PPRWGS     |  | -     | 0       |
| PPSAT      |  | -     | 0       |
| PPSATCV    |  | -     | 0       |
| PPTWG      |  | -     | 0       |
| PPTWGR     |  | -     | 0       |
| PPTWGT     |  | -     | 0       |
| PPVAG      |  | _     | 0       |
| PQM        | Slope of normalized Tcen in inversion    | _     | 0.66    |
| PQMACC     | Slope of normalized Tcen in accumulation | _     | 0.66    |
| PQMFACTOR  |  |       | 0       |
| PQMTCENCV  |  | -     | 0       |
| PQMTCENCVA |  | _     | 0       |
| PQMTCENIV  |  | _     | 0       |
| PRDDR      | Drain side quasi-saturation parameter    | -     | 0       |
| PRDSW      |  | _     | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter   | Description   | Units    | Default |
|-------------|---|----------|---------|
| PRDW        |   | _        | 0       |
| PRSDEND     |   | _        | 0       |
| PRSDR       | Source side quasi-saturation parameter                              | _        | 1       |
| PRSW        |   | _        | 0       |
| PRT         |   | _        | 0.001   |
| PRWGD       | Gate bias dependence of drain extension resistance                  | $V^{-1}$ | 0       |
| PRWGS       | Gate bias dependence of source extension resistance                 | $V^{-1}$ | 0       |
| PSAT        | Velocity saturation exponent, after binnig should be from [2.0:inf) | _        | 2       |
| PSATCV      | Velocity saturation exponent for C-V                                | _        | 0       |
| PSEJ        | Source to substrate PN junction perimeter (BULKMOD=1)               | _        | 0       |
| PSEO        | Perimeter of source to substrate overlap region through oxide       | -        | 0       |
| PSII0       |   | _        | 0       |
| PSII1       |   | _        | 0       |
| PSII2       |   | _        | 0       |
| PSIID       |   | _        | 0       |
| PSTTHETASAT |   | _        | 0       |
| PTGIDL      |   | _        | 0       |
| PTII        |   | _        | 0       |
| PTSS        |   | _        | 0       |
| PTWG        | Gmsat degradation parameter - forward mode                          | _        | 0       |
| PTWGR       | Gmsat degradation parameter - reverse mode                          | _        | 0       |
| PTWGT       |   | _        | 0.004   |
| PU0         |   | _        | 0       |
| PUA         |   | _        | 0       |
| PUA1        |   | _        | 0       |
| PUC         |   |          | 0       |
| PUC1        |   | _        | 0       |
| PUCS        |   | _        | 0       |
| PUCSTE      |   | _        | 0       |
| PUD         |   | _        | 0       |
| PUD1        |   | _        | 0       |
| PUP         |   | _        | 0       |
| PUTE        |   | _        | 0       |
| PUTL        |   | _        | 0       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| PVAG      |  | _     | 1       |
| PVSAT     |  | _     | 0       |
| PVSAT1    |  | _     | 0       |
| PVSAT1R   |  | _     | 0       |
| PVSATCV   |  | _     | 0       |
| PWR       |  | _     | 0       |
| PXRCRG1   |  | _     | 0       |
| PXRCRG2   |  | _     | 0       |
| QM0       | Knee-Point for Tcen in inversion (Charge normalized to Cox)                        | _     | 0.001   |
| QM0ACC    | Knee-Point for Tcen in accumulation (Charge normalized to Cox)                     | _     | 0.001   |
| QMFACTOR  | Prefactor + switch for QM Vth correction   | -     | 0       |
| QMTCENCV  | Prefactor + switch for QM Width and Toxeff correction for CV                       | -     | 0       |
| QMTCENCVA | Prefactor + switch for QM Width and Toxeff correction for CV (accumulation region) | _     | 0       |
| QMTCENIV  | Prefactor + switch for QM Width correction for IV                                  | _     | 0       |
| RDDR      | Drain side drift resistance parameter - forward mode                               | _     | 0       |
| RDDRR     | Drain side drift resistance parameter - reverse mode                               | _     | 0       |
| RDSMOD    | Resistance model selector  | _     | 0       |
| RDSW      |  | _     | 100     |
| RDSWMIN   |  | _     | 0       |
| RDW       |  | _     | 50      |
| RDWMIN    |  | _     | 0       |
| RGATEMOD  | Gate electrode resistor and ge node switcher — NOT USED IN XYCE                    | -     | 0       |
| RGEOA     | Fitting parameter for RGEOMOD=1  | _     | 1       |
| RGEOB     | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOC     | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOD     | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOE     | Fitting parameter for RGEOMOD=1  | _     | 0       |
| RGEOMOD   | Bias independent parasitic resistance model selector                               | _     | 0       |
| RGEXT     | Effective gate electrode external resistance                                       | _     | 0       |
| RGFIN     | Effective gate electrode per finger per fin resistance                             | _     | 0.001   |
| RHOC      |  |       | 1e-12   |
| RHORSD    |  | _     | 1       |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units    | Default  |
|-----------|---|----------|----------|
| RSDR      | Source side drift resistance parameter - forward mode           | _        | 0        |
| RSDRR     | Source side drift resistance parameter - reverse mode           | _        | 0        |
| RSHD      | Drain-side sheet resistance                                     | _        | 0        |
| RSHS      | Source-side sheet resistance                                    | _        | 0        |
| RSW       |   | _        | 50       |
| RSWMIN    |   | _        | 0        |
| RTH0      | Thermal resistance  | _        | 0.01     |
| SDTERM    |   | _        | 0        |
| SHMOD     | Self heating and T node switcher — NOT USED IN XYCE             | _        | 0        |
| SIIO      | Vgs dependent parameter of Iii                                  | $V^{-1}$ | 0.5      |
| SII1      | 1st Vgs dependent parameter of Iii                              | $V^{-1}$ | 0.1      |
| SII2      | 2nd Vgs dependent parameter of Iii                              | _        | 0        |
| SIID      | 3rd Vds dependent parameter of Iii                              | $V^{-1}$ | 0        |
| SJD       | Constant for drain-side two-step second junction                | _        | 0        |
| SJS       | Constant for source-side two-step second junction               | _        | 0        |
| SJSWD     | Constant for drain-side sidewall two-step second junction       | _        | 0        |
| SJSWGD    | Constant for source-side gate sidewall two-step second junction | _        | 0        |
| SJSWGS    | Constant for source-side gate sidewall two-step second junction | _        | 0        |
| SJSWS     | Constant for source-side sidewall two-step second junction      | _        | 0        |
| TBGASUB   | Bandgap Temperature Coefficient (eV / degrees)                  | _        | 0.000702 |
| TBGBSUB   | Bandgap Temperature Coefficient (degrees)                       | _        | 1108     |
| TCJ       | Temperature coefficient for CJS/CJD                             | _        | 0        |
| TCJSW     | Temperature coefficient for CJSWS/CJSWD                         | _        | 0        |
| TCJSWG    | Temperature coefficient for CJSWGS/CJSWGD                       | _        | 0        |
| TETA0     | Temperature dependence of DIBL coefficient, 1/K                 | _        | 0        |
| TETAOR    | Temperature dependence of Reverse-mode DIBL coefficient, 1/K    | _        | 0        |
| TFIN      | Body (Fin) thickness  | _        | 1.5e-08  |
| TGATE     | Gate height on top of the hard mask                             | _        | 3e-08    |
| TGIDL     | GIDL/GISL Temperature Dependence                                | _        | -0.003   |
| TII       | Impact Ionization Temperature Dependence, IIMOD=2               | _        | 0        |
| TMASK     | Height of hard mask on top of the fin                           | _        | 3e-08    |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description   | Units | Default   |
|-----------|---|-------|-----------|
| TMEXP     |   | _     | 0         |
| TMEXPR    |   | _     | 0         |
| TNJTS     | Temperature coefficient for NJTS  | _     | 0         |
| TNJTSD    | Temperature coefficient for NJTSD   | _     | 0         |
| TNJTSSW   | Temperature coefficient for NJTSSW  | _     | 0         |
| TNJTSSWD  | NTemperature coefficient for NJTSSWD  | _     | 0         |
| TNJTSSWG  | Temperature coefficient for NJTSSWG   | _     | 0         |
| TNJTSSWGD | Temperature coefficient for NJTSSWGD  | _     | 0         |
| TNOM      | Temperature at which the model is extracted (degrees)                           | _     | 27        |
| TOXG      | oxide thickness for gate current model in meters, Introduced in BSIM-CMG106.1.0 | m     | 0         |
| TOXP      | physical oxide thickness in meters  | _     | 1.2e-09   |
| TOXREF    | Target tox value [m]  | _     | 1.2e-09   |
| TPB       | Temperature coefficient for PBS/PBD   | _     | 0         |
| TPBSW     | Temperature coefficient for PBSWS/PBSWD   | _     | 0         |
| TPBSWG    | Temperature coefficient for PBSWGS/PBSWGD                                       | _     | 0         |
| TRDDR     |   | _     | 0         |
| TRSDR     |   | _     | 0         |
| TSILI     | Thickness of the silicide on top of the raised source/drain                     | _     | 1e-08     |
| TSS       | SSwing Temperature Coefficient (/ degrees)                                      | _     | 0         |
| U0        |   | _     | 0.03      |
| U0MULT    | Variability in carrier mobility   | _     | 1         |
| UON1      | NFIN dependence of U0   | _     | 0         |
| U0N2      | NFIN dependence of U0   | _     | 100000    |
| UA        |   | _     | 0.3       |
| UA1       |   | _     | 0.001032  |
| UC        | Body effect for mobility degradation parameter - BULKMOD=1                      | _     | 0         |
| UC1       |   | _     | 5.6e-11   |
| UCS       |   | _     | 1         |
| UCSTE     |   | _     | -0.004775 |
| UD        |   | _     | 0         |
| UD1       |   | _     | 0         |
| UP        |   | _     | 0         |
| UTE       |   | _     | 0         |
| UTL       |   | _     | -0.0015   |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| VSAT      |  | _     | 85000   |
| VSAT1     | Velocity Saturation parameter for I_on degradation - forward mode                                    | -     | 0       |
| VSAT1N1   | NFIN dependence of VSAT1   | _     | 0       |
| VSAT1N2   | NFIN dependence of VSAT1   | _     | 0       |
| VSAT1R    | Velocity Saturation parameter for I_on degradation - reverse mode                                    | -     | 0       |
| VSAT1RN1  | NFIN dependence of VSAT1R  | _     | 0       |
| VSAT1RN2  | NFIN dependence of VSAT1R  | _     | 0       |
| VSATCV    | Velocity Saturation parameter for CV   | _     | 0       |
| VSATN1    | NFIN dependence of VSAT  | _     | 0       |
| VSATN2    | NFIN dependence of VSAT  | _     | 100000  |
| VTSD      | Bottom drain junction trap-assisted current voltage dependent parameter                              | -     | 0       |
| VTSS      | Bottom source junction trap-assisted current voltage dependent parameter                             | _     | 10      |
| VTSSWD    | Unit length trap-assisted current voltage dependent parameter for sidewall drain junction            | -     | 0       |
| VTSSWGD   | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall drain junction  | -     | 0       |
| VTSSWGS   | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall source junction | _     | 10      |
| VTSSWS    | Unit length trap-assisted current voltage dependent parameter for sidewall source junction           | -     | 10      |
| WR        |  | _     | 1       |
| WTH0      | Width dependence coefficient for Rth and Cth   | _     | 0       |
| XJBVD     | Fitting parameter for drain diode breakdown current  | _     | 0       |
| XJBVS     | Fitting parameter for source diode breakdown current   | _     | 1       |
| KL        | L offset for channel length due to mask/etch effect  | _     | 0       |
| XRCRG1    |  | _     | 12      |
| XRCRG2    |  | _     | 1       |
| XTID      | Drain junction current temperature exponent  | _     | 0       |
| XTIS      | Source junction current temperature exponent   | _     | 3       |
| XTSD      | Power dependence of JTSD on temperature  | _     | 0       |
| XTSS      | Power dependence of JTSS on temperature  | _     | 0.02    |
| XTSSWD    | Power dependence of JTSSWD on temperature  | _     | 0       |
| XTSSWGD   | Power dependence of JTSSWGD on temperature   | _     | 0       |
| XTSSWGS   | Power dependence of JTSSWGS on temperature   | _     | 0.02    |

Table 2-128. BSIM-CMG FINFET v107.0.0 Device Model Parameters

| Parameter | Description                               | Units | Default |
|-----------|---|-------|---------|
| XTSSWS    | Power dependence of JTSSWS on temperature | _     | 0.02    |

Table 2-129. MOSFET level 107 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WEFF      | WEFF        | -     | none    |
| LEFF      | LEFF        | _     | none    |
| WEFFCV    | WEFFCV      | _     | none    |
| LEFFCV    | LEFFCV      | _     | none    |
| IDS       | IDS         | _     | none    |
| IDEFF     | IDEFF       | _     | none    |
| ISEFF     | ISEFF       | _     | none    |
| IGTOT     | IGTOT       | -     | none    |
| IDSGEN    | IDSGEN      | -     | none    |
| III       | III         | _     | none    |
| IGIDL     | IGIDL       | _     | none    |
| IGISL     | IGISL       | _     | none    |
| IJSB      | IJSB        | _     | none    |
| IJDB      | IJDB        | _     | none    |
| ISUB      | ISUB        | -     | none    |
| BETA      | BETA        | _     | none    |
| VTH       | VTH         | _     | none    |
| VDSSAT    | VDSSAT      | -     | none    |
| VFB       | VFB         | -     | none    |
| GM        | GM          | -     | none    |
| GDS       | GDS         | -     | none    |
| GMBS      | GMBS        | -     | none    |
| QGI       | QGI         | -     | none    |
| QDI       | QDI         | -     | none    |
| QSI       | QSI         | -     | none    |
| QBI       | QBI         | -     | none    |
| QG        | QG          | _     | none    |
| QD        | QD          | _     | none    |
| QS        | QS          | _     | none    |
| QB        | QB          | _     | none    |
| CGGI      | CGGI        | _     | none    |
|           |             |       |         |

Table 2-129. MOSFET level 107 Output Variables

| D         | Table 2-123. MOOI ET level 107 Outp |       | D.CW    |
|-----------|-------------------------------------|-------|---------|
| Parameter | Description                         | Units | Default |
| CGSI      | CGSI                                |       | none    |
| CGDI      | CGDI                                | _     | none    |
| CGEI      | CGEI                                | _     | none    |
| CDGI      | CDGI                                | _     | none    |
| CDDI      | CDDI                                | _     | none    |
| CDSI      | CDSI                                | _     | none    |
| CDEI      | CDEI                                | _     | none    |
| CSGI      | CSGI                                | _     | none    |
| CSDI      | CSDI                                | _     | none    |
| CSSI      | CSSI                                | _     | none    |
| CSEI      | CSEI                                | _     | none    |
| CEGI      | CEGI                                | _     | none    |
| CEDI      | CEDI                                | _     | none    |
| CESI      | CESI                                | _     | none    |
| CEEI      | CEEI                                | -     | none    |
| CGG       | CGG                                 | _     | none    |
| CGS       | CGS                                 | _     | none    |
| CGD       | CGD                                 | _     | none    |
| CGE       | CGE                                 | _     | none    |
| CDG       | CDG                                 | _     | none    |
| CDD       | CDD                                 | _     | none    |
| CDS       | CDS                                 | _     | none    |
| CDE       | CDE                                 | _     | none    |
| CSG       | CSG                                 | _     | none    |
| CSD       | CSD                                 | _     | none    |
| CSS       | CSS                                 | _     | none    |
| CSE       | CSE                                 | _     | none    |
| CEG       | CEG                                 | _     | none    |
| CED       | CED                                 | _     | none    |
| CES       | CES                                 | -     | none    |
| CEE       | CEE                                 | _     | none    |
| CGSEXT    | CGSEXT                              | -     | none    |
| CGDEXT    | CGDEXT                              | -     | none    |
| CGBOV     | CGBOV                               | -     | none    |
| CJST      | CJST                                | -     | none    |
| CJDT      | CJDT                                | _     | none    |
|           |                                     |       |         |

Table 2-129. MOSFET level 107 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| RSGEO     | RSGEO       | _     | none    |
| RDGEO     | RDGEO       | _     | none    |
| CFGEO     | CFGEO       | -     | none    |

Table 2-130. BSIM-CMG FINFET v108.0.0 Device Instance Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| ADEJ      | Drain junction area (BULKMOD=1)                               | _     | 0       |
| ADEO      | Drain to substrate overlap area through oxide                 | _     | 0       |
| ASEJ      | Source junction area (BULKMOD=1)                              | _     | 0       |
| ASEO      | Source to substrate overlap area through oxide                | _     | 0       |
| CDSP      | Constant drain-to-source fringe capacitance (All CGEOMOD)     | -     | 0       |
| CGDP      | Constant gate-to-drain fringe capacitance (CGEOMOD=1)         | -     | 0       |
| CGSP      | Constant gate-to-source fringe capacitance (CGEOMOD=1)        | -     | 0       |
| COVD      | Constant g/d overlap capacitance (CGEOMOD=1)                  | _     | 0       |
| COVS      | Constant g/s overlap capacitance (CGEOMOD=1)                  | _     | 0       |
| D         | Diameter of the cylinder (GEOMOD=3)                           | _     | 4e-08   |
| FPITCH    | Fin pitch   | _     | 8e-08   |
| L         | Designed Gate Length  | _     | 3e-08   |
| LRSD      | Length of the source/drain                                    | _     | 0       |
| M         | multiplicity factor   | _     | 1       |
| NF        | Number of fingers   |       | 1       |
| NFIN      | Number of fins per finger (real number enables optimization)  |       | 1       |
| NGCON     | number of gate contact (1 or 2 sided)                         | _     | 1       |
| NRD       | Number of source diffusion squares                            | _     | 0       |
| NRS       | Number of source diffusion squares                            | _     | 0       |
| PDEJ      | Drain to substrate PN junction perimeter (BULKMOD=1)          | -     | 0       |
| PDEO      | Perimeter of drain to substrate overlap region through oxide  |       | 0       |
| PSEJ      | Source to substrate PN junction perimeter (BULKMOD=1)         |       | 0       |
| PSEO      | Perimeter of source to substrate overlap region through oxide |       | 0       |
| TFIN      | Body (Fin) thickness  | _     | 1.5e-08 |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default   |
|-----------|---|-------|-----------|
| A1        | Non-saturation effect parameter for strong inversion region   | -     | 0         |
| A11       | Temperature dependence of A1                                  | _     | 0         |
| A2        | Non-saturation effect parameter for moderate inversion region | _     | 0         |
| A21       | Temperature dependence of A2                                  | _     | 0         |
| ADEJ      | Drain junction area (BULKMOD=1)                               | _     | 0         |
| ADEO      | Drain to substrate overlap area through oxide                 | _     | 0         |
| AEU       |   | _     | 0         |
| AEUR      |   | _     | 0         |
| AGIDL     | pre-exponential coeff. for GIDL in mho                        | _     | 0         |
| AGISL     | pre-exponential coeff. for GISL in mho                        | _     | 6.055e-12 |
| AIGBACC   | parameter for Igb in accumulation                             | _     | 0.0136    |
| AIGBACC1  | parameter for Igb in accumulation                             | _     | 0         |
| AIGBINV   | parameter for Igb in inversion                                | _     | 0.0111    |
| AIGBINV1  | parameter for Igb in inversion                                | _     | 0         |
| AIGC      | parameter for Igc in inversion                                | _     | 0.0136    |
| AIGC1     | parameter for Igc in inversion                                | _     | 0         |
| AIGD      | parameter for Igd in inversion                                | _     | 0         |
| AIGD1     | parameter for Igd in inversion                                | _     | 0         |
| AIGEN     | Thermal Generation Current Parameter                          | _     | 0         |
| AIGS      | parameter for Igs in inversion                                | _     | 0.0136    |
| AIGS1     | parameter for Igs in inversion                                | _     | 0         |
| ALPHA0    | first parameter of Iii, m/V                                   | _     | 0         |
| ALPHA01   | Temperature dependence of ALPHA0, m/V/degrees                 | _     | 0         |
| ALPHA1    | L scaling parameter of Iii, 1/V                               | _     | 0         |
| ALPHA11   | Temperature dependence ALPHA1, 1/V/degree                     | _     | 0         |
| ALPHAIIO  | first parameter of Iii for IIMOD=2, m/V                       | _     | 0         |
| ALPHAII01 | Temperature dependence of ALPHAII0, m/V/degrees               | _     | 0         |
| ALPHAII1  | L scaling parameter of Iii for IIMOD=2, 1/V                   | _     | 0         |
| ALPHAII11 | Temperature dependence of ALPHAII1, 1/V/degrees               | _     | 0         |
| AMEXP     |   | _     | 0         |
| AMEXPR    |   | _     | 0         |
| APCLM     |   | _     | 0         |
| APCLMR    |   | _     | 0         |
| APSAT     |   | _     | 0         |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| APSATCV   |   | _     | 0        |
| APTWG     |   | _     | 0        |
| AQMTCEN   | Parameter for Geometric dependence of Tcen on R/TFIN/HFIN | _     | 0        |
| ARDSW     |   | _     | 0        |
| ARDW      |   | _     | 0        |
| ARSDEND   |   | _     | 0        |
| ARSW      |   | _     | 0        |
| ASEJ      | Source junction area (BULKMOD=1)                          | _     | 0        |
| ASEO      | Source to substrate overlap area through oxide            | _     | 0        |
| ASILIEND  |   | _     | 0        |
| ASYMMOD   | Asymmetric model selector                                 | _     | 0        |
| AT        |   | _     | -0.00156 |
| ATCV      |   | _     | 0        |
| ATR       |   | _     | 0        |
| AUA       |   | _     | 0        |
| AUAR      |   | _     | 0        |
| AUD       |   | _     | 0        |
| AUDR      |   | _     | 0        |
| AVSAT     |   | _     | 0        |
| AVSAT1    |   | _     | 0        |
| AVSATCV   |   | _     | 0        |
| BETA0     | Vds dependent parameter of Iii, 1/V                       | _     | 0        |
| BETAIIO   | Vds dependent parameter of Iii, 1/V                       | _     | 0        |
| BETAII1   | Vds dependent parameter of Iii                            | _     | 0        |
| BETAII2   | Vds dependent parameter of Iii, V                         | _     | 0.1      |
| BEU       |   | _     | 1e-07    |
| BEUR      |   | _     | 0        |
| BG0SUB    | Band gap of substrate at 300.15K, eV                      | _     | 1.12     |
| BGIDL     | exponential coeff. for GIDL in V/m                        | _     | 0        |
| BGISL     | exponential coeff. for GISL in V/m                        | _     | 3e+08    |
| BIGBACC   | parameter for Igb in accumulation                         | _     | 0.00171  |
| BIGBINV   | parameter for Igb in inversion                            | _     | 0.000949 |
| BIGC      | parameter for Igc in inversion                            | _     | 0.00171  |
| BIGD      | parameter for Igd in inversion                            | _     | 0        |
| BIGEN     | Thermal Generation Current Parameter                      | _     | 0        |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| BIGS      | parameter for Igs in inversion                             | -     | 0.00171 |
| BMEXP     |  | -     | 1       |
| BMEXPR    |  | _     | 0       |
| BPCLM     |  | -     | 1e-07   |
| BPCLMR    |  | _     | 0       |
| BPSAT     |  | -     | 1       |
| BPSATCV   |  | -     | 0       |
| BPTWG     |  | -     | 1e-07   |
| BQMTCEN   | Parameter for Geometric dependence of Tcen on R/TFIN/HFIN  | _     | 1.2e-08 |
| BRDSW     |  | -     | 1e-07   |
| BRDW      |  | _     | 1e-07   |
| BRSW      |  | _     | 1e-07   |
| BUA       |  | _     | 1e-07   |
| BUAR      |  | _     | 0       |
| BUD       |  | _     | 5e-08   |
| BUDR      |  | _     | 0       |
| BULKMOD   | Bulk model   | _     | 0       |
| BVD       | Drain diode breakdown voltage                              | _     | 0       |
| BVS       | Source diode breakdown voltage                             | _     | 10      |
| BVSAT     |  | _     | 1e-07   |
| BVSAT1    |  | _     | 0       |
| BVSATCV   |  | _     | 0       |
| CAPMOD    | Accumulation capacitance selector                          | _     | 0       |
| CDSC      | coupling capacitance between S/D and channel               | _     | 0.007   |
| CDSCD     | drain-bias sensitivity of CDSC                             | _     | 0.007   |
| CDSCDN1   | NFIN dependence of CDSCD                                   | _     | 0       |
| CDSCDN2   | NFIN dependence of CDSCD                                   | _     | 100000  |
| CDSCDR    | Reverse-mode drain-bias sensitivity of CDSC (Experimental) | -     | 0       |
| CDSCDRN1  | NFIN dependence of CDSCD                                   | _     | 0       |
| CDSCDRN2  | NFIN dependence of CDSCD                                   | _     | 0       |
| CDSCN1    | NFIN dependence of CDSC                                    | _     | 0       |
| CDSCN2    | NFIN dependence of CDSC                                    | _     | 100000  |
| CDSP      | Constant drain-to-source fringe capacitance (All CGEOMOD)  | -     | 0       |
| CFD       | Outer Fringe Cap (drain side)                              | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| CFS       | Outer Fringe Cap (source side)   | _     | 2.5e-11 |
| CGBL      | Bias dependent component of Gate to substrate overlap cap per unit channel length per fin per finger |       | 0       |
| CGBN      | Gate to substrate overlap cap per unit channel length per fin per finger                             | _     | 0       |
| CGBO      | Gate to substrate overlap cap per unit channel length per finger per NGCON                           | _     | 0       |
| CGDL      |  | _     | 0       |
| CGDO      | Non LDD region drain-gate overlap capacitance per unit channel width                                 | -     | 0       |
| CGDP      | Constant gate-to-drain fringe capacitance (CGEOMOD=1)  | -     | 0       |
| CGE01SW   |  |       | 0       |
| CGEOA     | Fitting parameter for CGEOMOD=2  |       | 1       |
| CGEOB     | Fitting parameter for CGEOMOD=2  | _     | 0       |
| CGEOC     | Fitting parameter for CGEOMOD=2  | _     | 0       |
| CGEOD     | Fitting parameter for CGEOMOD=2  | _     | 0       |
| CGEOE     | Fitting parameter for CGEOMOD=2  | _     | 1       |
| CGEOMOD   | Geometry dependent parasitic capacitance model selector  | _     | 0       |
| CGIDL     | parameter for body-effect of GIDL in V**3  | _     | 0       |
| CGISL     | parameter for body-effect of GISL in V**3  | _     | 0.5     |
| CGSL      |  |       | 0       |
| CGSO      | Non LDD region source-gate overlap capacitance per unit channel width                                |       | 0       |
| CGSP      | Constant gate-to-source fringe capacitance (CGEOMOD=1)   | _     | 0       |
| CHARGEWF  | Average Channel Charge Weighting Factor,<br>+1:source-side, 0:middle, -1:drain-side                  |       | 0       |
| CIGBACC   | parameter for Igb in accumulation  | _     | 0.075   |
| CIGBINV   | parameter for Igb in inversion   |       | 0.006   |
| CIGC      | parameter for Igc in inversion   | _     | 0.075   |
| CIGD      | parameter for Igd in inversion   |       | 0       |
| CIGS      | parameter for Igs in inversion   |       | 0.075   |
| CIT       | parameter for interface trap   | _     | 0       |
| CITR      | parameter for interface trap in reverse mode for asymmetric model                                    | _     | 0       |
| CJD       | Unit area drain-side junction capacitance at zero bias   | _     | 0       |
| CJS       | Unit area source-side junction capacitance at zero bias  | _     | 0.0005  |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| CJSWD       | Unit length drain-side sidewall junction capacitance at zero bias       | _     | 0       |
| CJSWGD      | Unit length drain-side gate sidewall junction capacitance at zero bias  | _     | 0       |
| CJSWGS      | Unit length source-side gate sidewall junction capacitance at zero bias | _     | 0       |
| CJSWS       | Unit length source-side sidewall junction capacitance at zero bias      | _     | 5e-10   |
| СКАРРАВ     |   | _     | 0.6     |
| CKAPPAD     |   | _     | 0       |
| CKAPPAS     |   | _     | 0.6     |
| COREMOD     | Surface potential algorithm   | _     | 0       |
| COVD        | Constant g/d overlap capacitance (CGEOMOD=1)                            | _     | 0       |
| COVS        | Constant g/s overlap capacitance (CGEOMOD=1)                            | _     | 0       |
| CRATIO      |   | _     | 0.5     |
| CSDESW      | Coefficient for source/drain to substrate sidewall cap                  | _     | 0       |
| CTH0        | Thermal capacitance   | _     | 1e-05   |
| D           | Diameter of the cylinder (GEOMOD=3)                                     | _     | 4e-08   |
| DELTAPRSD   |   | _     | 0       |
| DELTAVSAT   |   | _     | 1       |
| DELTAVSATCV |   | _     | 0       |
| DELTAW      | change of effective width due to shape of fin/cylinder                  | _     | 0       |
| DELTAWCV    | CV change of effective width due to shape of fin/cylinder               | _     | 0       |
| DELVFBACC   | Change in Flatband Voltage; Vfb_accumulation-Vfb_inversion              | _     | 0       |
| DELVTRAND   | Variability in Vth  | _     | 0       |
| DEVTYPE     |   | _     | 1       |
| DLBIN       | Delta L for Binning   | _     | 0       |
| DLC         | Delta L for C-V model   | _     | 0       |
| DLCACC      | Delta L for C-V model in accumulation region (CAPMOD=1, BULKMOD=1)      | _     | 0       |
| DLCIGD      | Delta L for Igd model   | _     | 0       |
| DLCIGS      | Delta L for Igs model   | _     | 0       |
| DROUT       |   | _     | 1.06    |
| DSUB        | DIBL exponent coefficient   | _     | 1.06    |
| DTEMP       | Variability in Device Temperature                                       | _     | 0       |
| DVT0        | SCE coefficient   | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DVT1      | SCE exponent coefficient, after binning should be in (0:inf)                               |       | 0.6     |
| DVT1SS    | Subthreshold Swing exponent coefficient, after binning should be in (0:inf)                |       | 0       |
| DVTP0     | Coefficient for Drain-Induced Vth Shift (DITS)   | _     | 0       |
| DVTP1     | DITS exponent coefficient  | _     | 0       |
| DVTSHIFT  | Vth shift handle   | _     | 0       |
| DVTSHIFTR | Vth shift handle for asymmetric mode   | _     | 0       |
| EASUB     | Electron affinity of substrate, eV   | _     | 4.05    |
| EF        | Flicker Noise frequency exponent   | _     | 1       |
| EGIDL     | band bending parameter for GIDL in V   | _     | 0       |
| EGISL     | band bending parameter for GISL in V   | _     | 0.2     |
| EIGBINV   | parameter for Igb in inversion   | _     | 1.1     |
| EM        |  | _     | 4.1e+07 |
| EMOBT     |  | _     | 0       |
| EOT       | equivalent oxide thickness in meters   | _     | 1e-09   |
| EOTACC    | equivalent oxide thickness for accumulation region in meters                               |       | 0       |
| EOTBOX    | equivalent oxide thickness of the buried oxide (SOI FinFET) or STI (bulk FinFET) in meters |       | 1.4e-07 |
| EPSROX    | Relative dielectric constant of the gate dielectric  |       | 3.9     |
| EPSRSP    | Relative dielectric constant of the spacer   | _     | 3.9     |
| EPSRSUB   | Relative dielectric constant of the channel material                                       | _     | 11.9    |
| ESATII    | Saturation channel E-Field for Iii, V/m  | _     | 1e+07   |
| ETA0      | DIBL coefficient   | _     | 0.6     |
| ETA0N1    | NFIN dependence of ETA0  | _     | 0       |
| ETA0N2    | NFIN dependence of ETA0  | _     | 100000  |
| ETA0R     | Reverse-mode DIBL coefficient (Experimental)   | _     | 0       |
| ETAMOB    |  | _     | 2       |
| ETAQM     | Bulk charge coefficient for Tcen   | _     | 0.54    |
| EU        |  | _     | 2.5     |
| EUR       |  | _     | 0       |
| FECH      | End-channel factor, for different orientation/shape  | _     | 1       |
| FECHCV    | CV end-channel factor, for different orientation/shape                                     | _     | 1       |
| FPITCH    | Fin pitch  | _     | 8e-08   |
| GEOMOD    | Geometry mode selector   | _     | 1       |
| GIDLMOD   | GIDL/GISL current switcher   | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| HEPI      | Height of the raised source/drain on top of the fin                                 | _     | 1e-08   |
| HFIN      | Fin height in meters  | _     | 3e-08   |
| IDSOMULT  | Variability in Drain current for misc. reasons                                      |       | 1       |
| IGBMOD    | Model selector for Igb  | _     | 0       |
| IGCMOD    | Model selector for Igc, Igs, and Igd  | _     | 0       |
| IGT       | Gate Current Temperature Dependence   | _     | 2.5     |
| IMOD      | Impact ionization model switch  | _     | 0       |
| IIT       | Impact Ionization Temperature Dependence, IIMOD=1                                   | _     | -0.5    |
| JTHDFWD   | Forward drain diode breakdown limiting current                                      | _     | 0       |
| JTHDREV   | Reverse drain diode breakdown limiting current                                      | _     | 0       |
| JTHSFWD   | Forward source diode breakdown limiting current                                     | _     | 0.1     |
| JTHSREV   | Reverse source diode breakdown limiting current                                     | _     | 0.1     |
| MIN       | Parameter for Vgs Clamping for inversion region calc. in accumulation               | _     | 1e-15   |
| ISD       | Bottom drain junction reverse saturation current density                            | -     | 0       |
| JSS       | Bottom source junction reverse saturation current density                           | _     | 0.0001  |
| JSWD      | Unit length reverse saturation current for sidewall drain junction                  | -     | 0       |
| JSWGD     | Unit length reverse saturation current for gate-edge sidewall drain junction        | _     | 0       |
| SWGS      | Unit length reverse saturation current for gate-edge sidewall source junction       | _     | 0       |
| SWS       | Unit length reverse saturation current for sidewall source junction                 | -     | 0       |
| TSD       | Bottom drain junction trap-assisted saturation current density                      | -     | 0       |
| TSS       | Bottom source junction trap-assisted saturation current density                     | _     | 0       |
| TSSWD     | Unit length trap-assisted saturation current for sidewall drain junction            | _     | 0       |
| TSSWGD    | Unit length trap-assisted saturation current for gate-edge sidewall drain junction  | _     | 0       |
| TSSWGS    | Unit length trap-assisted saturation current for gate-edge sidewall source junction | _     | 0       |
| TSSWS     | Unit length trap-assisted saturation current for sidewall source junction           | _     | 0       |
| TWEFF     | Trap assisted tunneling current width dependence                                    | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| K0        | Lateral NUD voltage parameter, V  | _     | 0       |
| K01       | Temperature dependence of lateral NUD voltage parameter, V/K                              | _     | 0       |
| KOSI      | Correction factor for strong inversion, used in Mnud, after binnig should be from (0:inf) | _     | 1       |
| K0SI1     | Temperature dependence of K0SI, 1/K   | _     | 0       |
| K1        | Body effect coefficient for sub-threshold region  | -     | 0       |
| K11       | Temperature dependence of K1  | _     | 0       |
| K1RSCE    | K1 for reverse short channel effect calculation   | _     | 0       |
| K1SAT     | Correction factor for K1 in saturation (high Vds)   | _     | 0       |
| K1SAT1    | Temperature dependence of K1SAT1  | _     | 0       |
| K1SI      | Correction factor for strong inversion, used in Mob                                       | _     | 0       |
| K1SI1     | Temperature dependence of K1SI, 1/K   | _     | 0       |
| KSATIV    |   | _     | 1       |
| KSATIVR   | KSATIV in asymmetric mode   | _     | 0       |
| KT1       | Vth Temperature Coefficient (V)   | _     | 0       |
| KT1L      | Vth Temperature L Coefficient (m-V)   | _     | 0       |
| L         | Designed Gate Length  | _     | 3e-08   |
| LA1       |   | _     | 0       |
| LA11      |   | _     | 0       |
| LA2       |   | _     | 0       |
| LA21      |   | _     | 0       |
| LAGIDL    |   | _     | 0       |
| LAGISL    |   | _     | 0       |
| LAIGBACC  |   | _     | 0       |
| LAIGBACC1 |   | _     | 0       |
| LAIGBINV  |   | _     | 0       |
| LAIGBINV1 |   | _     | 0       |
| LAIGC     |   | _     | 0       |
| LAIGC1    |   | _     | 0       |
| LAIGD     |   | _     | 0       |
| LAIGD1    |   | _     | 0       |
| LAIGEN    |   | _     | 0       |
| LAIGS     |   | _     | 0       |
| LAIGS1    |   | _     | 0       |
| LALPHA0   |   | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| LALPHA1   |             | _     | 0       |
| LALPHAIIO |             | _     | 0       |
| LALPHAII1 |             | _     | 0       |
| LAT       |             | _     | 0       |
| LATCV     |             | _     | 0       |
| LATR      |             | -     | 0       |
| LBETA0    |             | -     | 0       |
| LBETAII0  |             | -     | 0       |
| LBETAII1  |             | _     | 0       |
| LBETAII2  |             | -     | 0       |
| LBGIDL    |             | _     | 0       |
| LBGISL    |             | _     | 0       |
| LBIGBACC  |             | _     | 0       |
| LBIGBINV  |             | _     | 0       |
| LBIGC     |             | -     | 0       |
| LBIGD     |             | _     | 0       |
| LBIGEN    |             | _     | 0       |
| LBIGS     |             | _     | 0       |
| LCDSC     |             | -     | 0       |
| LCDSCD    |             | -     | 0       |
| LCDSCDR   |             | _     | 0       |
| LCFD      |             | -     | 0       |
| LCFS      |             | _     | 0       |
| LCGBL     |             | _     | 0       |
| LCGDL     |             | -     | 0       |
| LCGIDL    |             | _     | 0       |
| LCGISL    |             | _     | 0       |
| LCGSL     |             | -     | 0       |
| LCIGBACC  |             | -     | 0       |
| LCIGBINV  |             | _     | 0       |
| LCIGC     |             | _     | 0       |
| LCIGD     |             | _     | 0       |
| LCIGS     |             | _     | 0       |
| LCIT      |             | _     | 0       |
| LCITR     |             | _     | 0       |
| LCKAPPAB  |             | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter    | Description  | Units | Default |
|--------------|--|-------|---------|
| LCKAPPAD     |  | _     | 0       |
| LCKAPPAS     |  | _     | 0       |
| LCOVD        |  | _     | 0       |
| LCOVS        |  | _     | 0       |
| LDELTAVSAT   |  | _     | 0       |
| LDELTAVSATCV |  | _     | 0       |
| LDROUT       |  | _     | 0       |
| LDSUB        |  | _     | 0       |
| LDVT0        |  | _     | 0       |
| LDVT1        |  | _     | 0       |
| LDVT1SS      |  | _     | 0       |
| LDVTB        |  | _     | 0       |
| LDVTSHIFT    |  | _     | 0       |
| LDVTSHIFTR   |  | _     | 0       |
| LEGIDL       |  | _     | 0       |
| LEGISL       |  | _     | 0       |
| LEIGBINV     |  | _     | 0       |
| LEMOBT       |  | _     | 0       |
| LESATII      |  | _     | 0       |
| LETA0        |  | _     | 0       |
| LETA0R       |  | _     | 0       |
| LETAMOB      |  | _     | 0       |
| LEU          |  | _     | 0       |
| LEUR         |  | _     | 0       |
| LIGT         |  | _     | 0       |
| LII          | Channel length dependent parameter of Iii, V-m       | _     | 5e-10   |
| LIIT         |  | _     | 0       |
| LINT         | Length reduction parameter (dopant diffusion effect) | _     | 0       |
| LINTIGEN     | Lint for Thermal Generation Current                  | _     | 0       |
| LINTNOI      |  | _     | 0       |
| LK0          |  | _     | 0       |
| LK01         |  | _     | 0       |
| LKOSI        |  | _     | 0       |
| LK0SI1       |  | _     | 0       |
| LK1          |  | _     | 0       |
| <br>LK11     |  | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LK1RSCE   |  | _     | 0       |
| LK1SAT    |  | _     | 0       |
| LK1SAT1   |  | _     | 0       |
| LK1SI     |  | _     | 0       |
| LK1SI1    |  | _     | 0       |
| LKSATIV   |  | _     | 0       |
| LKSATIVR  |  | _     | 0       |
| LKT1      |  | _     | 0       |
| LL        | Length reduction parameter (dopant diffusion effect) | _     | 0       |
| LLC       | Length reduction parameter (dopant diffusion effect) | _     | 0       |
| LLII      |  | _     | 0       |
| LLN       | Length reduction parameter (dopant diffusion effect) | _     | 1       |
| LLPE0     |  | _     | 0       |
| LLPEB     |  | _     | 0       |
| LMAX      | Maximum length for which this model should be used.  | _     | 100     |
| LMEXP     |  | _     | 0       |
| LMEXPR    |  | _     | 0       |
| LMIN      | Minimum length for which this model should be used.  | _     | 0       |
| LNBODY    |  | _     | 0       |
| LNGATE    |  | _     | 0       |
| LNIGBACC  |  | _     | 0       |
| LNIGBINV  |  | _     | 0       |
| LNTGEN    |  | _     | 0       |
| LNTOX     |  | _     | 0       |
| LPA       |  | _     | 1       |
| LPAR      |  | _     | 0       |
| LPCLM     |  | _     | 0       |
| LPCLMCV   |  | _     | 0       |
| LPCLMG    |  | _     | 0       |
| LPCLMR    |  | _     | 0       |
| LPDIBL1   |  | _     | 0       |
| LPDIBL1R  |  | _     | 0       |
| LPDIBL2   |  | _     | 0       |
| LPDIBL2R  |  | _     | 0       |
| LPE0      | Equivalent length of pocket region at zero bias      | _     | 5e-09   |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter   | Description                | Units | Default |
|-------------|----------------------------|-------|---------|
| LPGIDL      |                            | _     | 0       |
| LPGISL      |                            | _     | 0       |
| LPHIBE      |                            | _     | 0       |
| LPHIG       |                            | _     | 0       |
| LPHIN       |                            | _     | 0       |
| LPIGCD      |                            | _     | 0       |
| LPOXEDGE    |                            | _     | 0       |
| LPRT        |                            | _     | 0       |
| LPRWGD      |                            | _     | 0       |
| LPRWGS      |                            | _     | 0       |
| LPSAT       |                            | _     | 0       |
| LPSATCV     |                            | _     | 0       |
| LPTWG       |                            | _     | 0       |
| LPTWGR      |                            | _     | 0       |
| LPTWGT      |                            | _     | 0       |
| LPVAG       |                            | _     | 0       |
| LQMFACTOR   |                            | _     | 0       |
| LQMTCENCV   |                            | _     | 0       |
| LQMTCENCVA  |                            | _     | 0       |
| LQMTCENIV   |                            | _     | 0       |
| LRDSW       |                            | _     | 0       |
| LRDW        |                            | _     | 0       |
| LRSD        | Length of the source/drain | _     | 0       |
| LRSW        |                            | _     | 0       |
| LSIIO       |                            | _     | 0       |
| LSII1       |                            | _     | 0       |
| LSII2       |                            | _     | 0       |
| LSIID       |                            | _     | 0       |
| LSP         |                            | _     | 0       |
| LSTTHETASAT |                            | -     | 0       |
| LTGIDL      |                            | -     | 0       |
| LTII        |                            | _     | 0       |
| LTSS        |                            | -     | 0       |
| LU0         |                            | -     | 0       |
| LU0R        |                            | _     | 0       |
| LUA         |                            | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| LUA1      |  | _     | 0       |
| LUA1R     |  | _     | 0       |
| LUAR      |  | _     | 0       |
| LUC       |  | _     | 0       |
| LUC1      |  | _     | 0       |
| LUC1R     |  | _     | 0       |
| LUCR      |  | _     | 0       |
| LUCS      |  | _     | 0       |
| LUCSTE    |  | _     | 0       |
| LUD       |  | _     | 0       |
| LUD1      |  | _     | 0       |
| LUD1R     |  | _     | 0       |
| LUDR      |  | _     | 0       |
| LUP       |  | _     | 0       |
| LUTE      |  | _     | 0       |
| LUTER     |  | _     | 0       |
| LUTL      |  | _     | 0       |
| LUTLR     |  | _     | 0       |
| LVSAT     |  | _     | 0       |
| LVSAT1    |  | _     | 0       |
| LVSAT1R   |  | _     | 0       |
| LVSATCV   |  | _     | 0       |
| LVSATR    |  | _     | 0       |
| LWR       |  | _     | 0       |
| LXRCRG1   |  | _     | 0       |
| LXRCRG2   |  | _     | 0       |
| MEXP      |  | _     | 4       |
| MEXPR     |  | _     | 0       |
| MJD       | Drain bottom junction capacitance grading coefficient                  | _     | 0       |
| MJD2      | Drain bottom two-step second junction capacitance grading coefficient  | -     | 0       |
| MJS       | Source bottom junction capacitance grading coefficient                 | _     | 0.5     |
| MJS2      | Source bottom two-step second junction capacitance grading coefficient | -     | 0.125   |
| MJSWD     | Drain sidewall junction capacitance grading coefficient                | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| MJSWD2    | Drain sidewall two-step second junction capacitance grading coefficient            | _     | 0       |
| MJSWGD    | Drain-side gate sidewall junction capacitance grading coefficient                  | _     | 0       |
| MJSWGD2   | Drain-side gate sidewall two-step second junction capacitance grading coefficient  | _     | 0       |
| MJSWGS    | Source-side gate sidewall junction capacitance grading coefficient                 | _     | 0       |
| MJSWGS2   | Source-side gate sidewall two-step second junction capacitance grading coefficient | _     | 0       |
| MJSWS     | Source sidewall junction capacitance grading coefficient                           | _     | 0.33    |
| MJSWS2    | Source sidewall two-step second junction capacitance grading coefficient           | _     | 0.083   |
| NA1       |  | _     | 0       |
| NA11      |  | _     | 0       |
| NA2       |  | _     | 0       |
| NA21      |  | _     | 0       |
| NAGIDL    |  | _     | 0       |
| NAGISL    |  | _     | 0       |
| NAIGBACC  |  | _     | 0       |
| NAIGBACC1 |  | _     | 0       |
| NAIGBINV  |  | _     | 0       |
| NAIGBINV1 |  | _     | 0       |
| NAIGC     |  | _     | 0       |
| NAIGC1    |  | _     | 0       |
| NAIGD     |  | _     | 0       |
| NAIGD1    |  | _     | 0       |
| NAIGEN    |  | _     | 0       |
| NAIGS     |  | _     | 0       |
| NAIGS1    |  | _     | 0       |
| NALPHA0   |  | _     | 0       |
| NALPHA1   |  | _     | 0       |
| NALPHAIIO |  | _     | 0       |
| NALPHAII1 |  | _     | 0       |
| NAT       |  | _     | 0       |
| NATCV     |  | _     | 0       |
| NATR      |  | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description                              | Units | Default  |
|-----------|--|-------|----------|
| NBETA0    |  | _     | 0        |
| NBETAIIO  |  | _     | 0        |
| NBETAII1  |  | _     | 0        |
| NBETAII2  |  | _     | 0        |
| NBGIDL    |  | _     | 0        |
| NBGISL    |  | _     | 0        |
| NBIGBACC  |  | _     | 0        |
| NBIGBINV  |  | _     | 0        |
| NBIGC     |  | _     | 0        |
| NBIGD     |  | _     | 0        |
| NBIGEN    |  | _     | 0        |
| NBIGS     |  | _     | 0        |
| NBODY     | channel (body) doping                    | _     | 1e+22    |
| NBODYN1   | NFIN dependence of channel (body) doping | _     | 0        |
| NBODYN2   | NFIN dependence of channel (body) doping | _     | 100000   |
| NC0SUB    | Conduction band density of states, m-3   | _     | 2.86e+25 |
| NCDSC     |  | _     | 0        |
| NCDSCD    |  | _     | 0        |
| NCDSCDR   |  | _     | 0        |
| NCFD      |  | _     | 0        |
| NCFS      |  | _     | 0        |
| NCGBL     |  | _     | 0        |
| NCGDL     |  | _     | 0        |
| NCGIDL    |  | -     | 0        |
| NCGISL    |  | _     | 0        |
| NCGSL     |  | -     | 0        |
| NCIGBACC  |  | _     | 0        |
| NCIGBINV  |  | -     | 0        |
| NCIGC     |  | -     | 0        |
| NCIGD     |  | -     | 0        |
| NCIGS     |  | -     | 0        |
| NCIT      |  | -     | 0        |
| NCITR     |  | _     | 0        |
| NCKAPPAB  |  | _     | 0        |
| NCKAPPAD  |  | _     | 0        |
| NCKAPPAS  |  | _     | 0        |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter    | Description   | Units | Default |
|--------------|---|-------|---------|
| NCOVD        |   | _     | 0       |
| NCOVS        |   | _     | 0       |
| NDELTAVSAT   |   | _     | 0       |
| NDELTAVSATCV |   | _     | 0       |
| NDROUT       |   | _     | 0       |
| NDSUB        |   | _     | 0       |
| NDVT0        |   | _     | 0       |
| NDVT1        |   | _     | 0       |
| NDVT1SS      |   | _     | 0       |
| NDVTB        |   | _     | 0       |
| NDVTSHIFT    |   | _     | 0       |
| NDVTSHIFTR   |   | _     | 0       |
| NEGIDL       |   | _     | 0       |
| NEGISL       |   | _     | 0       |
| NEIGBINV     |   | _     | 0       |
| NEMOBT       |   | _     | 0       |
| NESATII      |   | _     | 0       |
| NETA0        |   | _     | 0       |
| NETA0R       |   | _     | 0       |
| NETAMOB      |   | _     | 0       |
| NEU          |   | _     | 0       |
| NEUR         |   | _     | 0       |
| NF           | Number of fingers   | _     | 1       |
| NFIN         | Number of fins per finger (real number enables optimization)          | _     | 1       |
| NFINMAX      | Maximum NFIN for which this model should be used.                     | _     | 100     |
| NFINMIN      | Minimum NFIN for which this model should be used.                     | _     | 0       |
| NGATE        | Parameter for Poly Gate Doping, for metal gate please set $NGATE = 0$ | _     | 0       |
| NGCON        | number of gate contact (1 or 2 sided)                                 | _     | 1       |
| NIOSUB       | Intrinsic carrier constant at 300.15K, m-3                            | _     | 1.1e+16 |
| NIGBACC      | parameter for Igb in accumulation                                     | _     | 1       |
| NIGBINV      | parameter for Igb in inversion  | _     | 3       |
| NIGT         |   | _     | 0       |
| NIIT         |   | _     | 0       |
| NJD          | Drain junction emission coefficient                                   | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description                          | Units | Default   |
|-----------|--------------------------------------|-------|-----------|
| NJS       | Source junction emission coefficient | -     | 1         |
| NJTS      | Non-ideality factor for JTSS         | _     | 20        |
| NJTSD     | Non-ideality factor for JTSD         | _     | 0         |
| NJTSSW    | Non-ideality factor for JTSSWS       | _     | 20        |
| NJTSSWD   | Non-ideality factor for JTSSWD       | _     | 0         |
| NJTSSWG   | Non-ideality factor for JTSSWGS      | _     | 20        |
| NJTSSWGD  | Non-ideality factor for JTSSWGD      | _     | 0         |
| NK0       |                                      | _     | 0         |
| NK01      |                                      | _     | 0         |
| NK0SI     |                                      | _     | 0         |
| NK0SI1    |                                      | _     | 0         |
| NK1       |                                      | _     | 0         |
| NK11      |                                      | _     | 0         |
| NK1RSCE   |                                      | _     | 0         |
| NK1SAT    |                                      | _     | 0         |
| NK1SAT1   |                                      | _     | 0         |
| NK1SI     |                                      | _     | 0         |
| NK1SI1    |                                      | _     | 0         |
| NKSATIV   |                                      | _     | 0         |
| NKSATIVR  |                                      | _     | 0         |
| NKT1      |                                      | _     | 0         |
| NLII      |                                      | _     | 0         |
| NLPE0     |                                      | _     | 0         |
| NLPEB     |                                      | _     | 0         |
| NMEXP     |                                      | _     | 0         |
| NMEXPR    |                                      | _     | 0         |
| NNBODY    |                                      | _     | 0         |
| NNGATE    |                                      | _     | 0         |
| NNIGBACC  |                                      | _     | 0         |
| NNIGBINV  |                                      | _     | 0         |
| NNTGEN    |                                      | _     | 0         |
| NNTOX     |                                      | _     | 0         |
| NOIA      |                                      | -     | 6.25e+39  |
| NOIB      |                                      | _     | 3.125e+24 |
| NOIC      |                                      | _     | 8.75e+07  |
| NPCLM     |                                      | _     | 0         |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| NPCLMCV    |   | _     | 0       |
| NPCLMG     |   | _     | 0       |
| NPCLMR     |   | _     | 0       |
| NPDIBL1    |   | _     | 0       |
| NPDIBL1R   |   | _     | 0       |
| NPDIBL2    |   | _     | 0       |
| NPDIBL2R   |   | _     | 0       |
| NPGIDL     |   | _     | 0       |
| NPGISL     |   | _     | 0       |
| NPHIBE     |   | _     | 0       |
| NPHIG      |   | _     | 0       |
| NPHIN      |   | _     | 0       |
| NPIGCD     |   | _     | 0       |
| NPOXEDGE   |   | _     | 0       |
| NPRT       |   | _     | 0       |
| NPRWGD     |   | _     | 0       |
| NPRWGS     |   | _     | 0       |
| NPSAT      |   | _     | 0       |
| NPSATCV    |   | _     | 0       |
| NPTWG      |   | _     | 0       |
| NPTWGR     |   | _     | 0       |
| NPTWGT     |   | _     | 0       |
| NPVAG      |   | _     | 0       |
| NQMFACTOR  |   | _     | 0       |
| NQMTCENCV  |   | _     | 0       |
| NQMTCENCVA |   | _     | 0       |
| NQMTCENIV  |   | _     | 0       |
| NQSMOD     |   | _     | 0       |
| NRD        | Number of source diffusion squares                    | _     | 0       |
| NRDSW      |   | _     | 0       |
| NRDW       |   | _     | 0       |
| NRS        | Number of source diffusion squares                    | _     | 0       |
| NRSW       |   | _     | 0       |
| NSD        | Source/drain active doping concentration in m-3       | _     | 2e+26   |
| NSDE       | Source/drain active doping concentration at Leff edge | _     | 2e+25   |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter   | Description  | Units | Default |
|-------------|--|-------|---------|
| NSEG        | Number of segments for NQSMOD=3 (3,5 and 10 supported) | -     | 4       |
| NSII0       |  | _     | 0       |
| NSII1       |  | _     | 0       |
| NSII2       |  | _     | 0       |
| NSIID       |  | _     | 0       |
| NSTTHETASAT |  | _     | 0       |
| NTGEN       | Thermal Generation Current Parameter                   | _     | 1       |
| NTGIDL      |  | _     | 0       |
| NTII        |  | _     | 0       |
| NTNOI       |  | _     | 1       |
| NTOX        | Exponent for Tox ratio                                 | _     | 1       |
| NTSS        |  | _     | 0       |
| NU0         |  | _     | 0       |
| NU0R        |  | _     | 0       |
| NUA         |  | _     | 0       |
| NUA1        |  | _     | 0       |
| NUA1R       |  | _     | 0       |
| NUAR        |  | _     | 0       |
| NUC         |  | _     | 0       |
| NUC1        |  | _     | 0       |
| NUC1R       |  | _     | 0       |
| NUCR        |  | _     | 0       |
| NUCS        |  | _     | 0       |
| NUCSTE      |  | _     | 0       |
| NUD         |  | -     | 0       |
| NUD1        |  | _     | 0       |
| NUD1R       |  | _     | 0       |
| NUDR        |  | _     | 0       |
| NUP         |  | _     | 0       |
| NUTE        |  | _     | 0       |
| NUTER       |  | _     | 0       |
| NUTL        |  | _     | 0       |
| NUTLR       |  | _     | 0       |
| NVSAT       |  | _     | 0       |
| NVSAT1      |  | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| NVSAT1R   |  | -     | 0       |
| NVSATCV   |  | _     | 0       |
| NVSATR    |  | _     | 0       |
| NVTM      | Subthreshold Swing factor multiplied by Vtm. If defined by user, will overwrite nVtm in the code | _     | 0       |
| NWR       |  | _     | 0       |
| NXRCRG1   |  | -     | 0       |
| NXRCRG2   |  | _     | 0       |
| PA1       |  | _     | 0       |
| PA11      |  | _     | 0       |
| PA2       |  | _     | 0       |
| PA21      |  | _     | 0       |
| PAGIDL    |  | _     | 0       |
| PAGISL    |  | _     | 0       |
| PAIGBACC  |  | _     | 0       |
| PAIGBACC1 |  | _     | 0       |
| PAIGBINV  |  | _     | 0       |
| PAIGBINV1 |  | _     | 0       |
| PAIGC     |  | _     | 0       |
| PAIGC1    |  | _     | 0       |
| PAIGD     |  | _     | 0       |
| PAIGD1    |  | _     | 0       |
| PAIGEN    |  | _     | 0       |
| PAIGS     |  | _     | 0       |
| PAIGS1    |  | _     | 0       |
| PALPHA0   |  | _     | 0       |
| PALPHA1   |  | _     | 0       |
| PALPHAIIO |  | _     | 0       |
| PALPHAII1 |  | _     | 0       |
| PAT       |  | _     | 0       |
| PATCV     |  | _     | 0       |
| PATR      |  | _     | 0       |
| PBD       | Drain-side bulk junction built-in potential  | _     | 0       |
| PBETA0    |  | _     | 0       |
| PBETAIIO  |  | _     | 0       |
| PBETAII1  |  | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PBETAII2  |   | _     | 0       |
| PBGIDL    |   | _     | 0       |
| PBGISL    |   | _     | 0       |
| PBIGBACC  |   | _     | 0       |
| PBIGBINV  |   | _     | 0       |
| PBIGC     |   | _     | 0       |
| PBIGD     |   | _     | 0       |
| PBIGEN    |   | _     | 0       |
| PBIGS     |   | _     | 0       |
| PBS       | Source-side bulk junction built-in potential                          | _     | 1       |
| PBSWD     | Built-in potential for Drain-side sidewall junction capacitance       | _     | 0       |
| PBSWGD    | Built-in potential for Drain-side gate sidewall junction capacitance  | _     | 0       |
| PBSWGS    | Built-in potential for Source-side gate sidewall junction capacitance | _     | 0       |
| PBSWS     | Built-in potential for Source-side sidewall junction capacitance      | _     | 1       |
| PCDSC     |   | _     | 0       |
| PCDSCD    |   | _     | 0       |
| PCDSCDR   |   | _     | 0       |
| PCFD      |   | _     | 0       |
| PCFS      |   | _     | 0       |
| PCGBL     |   | _     | 0       |
| PCGDL     |   | _     | 0       |
| PCGIDL    |   | -     | 0       |
| PCGISL    |   | _     | 0       |
| PCGSL     |   | _     | 0       |
| PCIGBACC  |   | _     | 0       |
| PCIGBINV  |   | _     | 0       |
| PCIGC     |   | _     | 0       |
| PCIGD     |   | _     | 0       |
| PCIGS     |   | _     | 0       |
| PCIT      |   | _     | 0       |
| PCITR     |   | _     | 0       |
| PCKAPPAB  |   | _     | 0       |
| PCKAPPAD  |   |       | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter    | Description  | Units | Default |
|--------------|--|-------|---------|
| PCKAPPAS     |  | _     | 0       |
| PCLM         |  | _     | 0.013   |
| PCLMCV       | CLM parameter for Short Channel CV                           | _     | 0       |
| PCLMG        |  | _     | 0       |
| PCLMR        | Reverse Model PCLM parameter                                 | _     | 0       |
| PCOVD        |  | _     | 0       |
| PCOVS        |  | _     | 0       |
| PDEJ         | Drain to substrate PN junction perimeter (BULKMOD=1)         | _     | 0       |
| PDELTAVSAT   |  | _     | 0       |
| PDELTAVSATCV |  | _     | 0       |
| PDEO         | Perimeter of drain to substrate overlap region through oxide | _     | 0       |
| PDIBL1       | DIBL Output Conductance parameter - forward mode             | _     | 1.3     |
| PDIBL1R      | DIBL Output Conductance parameter - reverse mode             | _     | 0       |
| PDIBL2       | DIBL Output Conductance parameter                            | _     | 0.0002  |
| PDIBL2R      | DIBL Output Conductance parameter - reverse mode             | _     | 0       |
| PDROUT       |  | _     | 0       |
| PDSUB        |  | _     | 0       |
| PDVT0        |  | _     | 0       |
| PDVT1        |  | _     | 0       |
| PDVT1SS      |  | _     | 0       |
| PDVTB        |  | _     | 0       |
| PDVTSHIFT    |  | _     | 0       |
| PDVTSHIFTR   |  | _     | 0       |
| PEGIDL       |  | _     | 0       |
| PEGISL       |  |       | 0       |
| PEIGBINV     |  | _     | 0       |
| PEMOBT       |  | _     | 0       |
| PESATII      |  | _     | 0       |
| PETA0        |  | _     | 0       |
| PETA0R       |  |       | 0       |
| PETAMOB      |  | _     | 0       |
| PEU          |  | _     | 0       |
| PEUR         |  | _     | 0       |
| PGIDL        | parameter for body-bias effect on GIDL                       | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| PGISL     | parameter for body-bias effect on GISL                                  | _     | 1       |
| PHIBE     | Body effect voltage parameter, V, after binnig should be from [0.2:1.2] | _     | 0.7     |
| PHIG      | Gate workfunction, eV   | _     | 4.61    |
| PHIGL     | Length dependence of Gate workfunction, eV/m                            | _     | 0       |
| PHIGN1    | NFIN dependence of Gate workfunction                                    | _     | 0       |
| PHIGN2    | NFIN dependence of Gate workfunction                                    | _     | 100000  |
| PHIN      | Nonuniform vertical doping effect on surface potential, V               | _     | 0.05    |
| PIGCD     | parameter for Igc partition   | _     | 1       |
| PIGT      |   | _     | 0       |
| PIIT      |   | _     | 0       |
| PK0       |   | _     | 0       |
| PK01      |   | _     | 0       |
| PK0SI     |   | _     | 0       |
| PK0SI1    |   | _     | 0       |
| PK1       |   | _     | 0       |
| PK11      |   | _     | 0       |
| PK1RSCE   |   | _     | 0       |
| PK1SAT    |   | _     | 0       |
| PK1SAT1   |   | _     | 0       |
| PK1SI     |   | _     | 0       |
| PK1SI1    |   | _     | 0       |
| PKSATIV   |   | -     | 0       |
| PKSATIVR  |   | _     | 0       |
| PKT1      |   | _     | 0       |
| PLII      |   | _     | 0       |
| PLPE0     |   | _     | 0       |
| PLPEB     |   | _     | 0       |
| PMEXP     |   | _     | 0       |
| PMEXPR    |   | _     | 0       |
| PNBODY    |   | _     | 0       |
| PNGATE    |   | _     | 0       |
| PNIGBACC  |   |       | 0       |
| PNIGBINV  |   | _     | 0       |
| PNTGEN    |   | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter  | Description                              | Units | Default |
|------------|--|-------|---------|
| PNTOX      |  | -     | 0       |
| POXEDGE    | Factor for the gate edge Tox             | _     | 1       |
| PPCLM      |  | _     | 0       |
| PPCLMCV    |  | _     | 0       |
| PPCLMG     |  | _     | 0       |
| PPCLMR     |  | _     | 0       |
| PPDIBL1    |  | _     | 0       |
| PPDIBL1R   |  | _     | 0       |
| PPDIBL2    |  | _     | 0       |
| PPDIBL2R   |  | -     | 0       |
| PPGIDL     |  | _     | 0       |
| PPGISL     |  | _     | 0       |
| PPHIBE     |  | _     | 0       |
| PPHIG      |  | _     | 0       |
| PPHIN      |  | _     | 0       |
| PPIGCD     |  | _     | 0       |
| PPOXEDGE   |  | _     | 0       |
| PPRT       |  | _     | 0       |
| PPRWGD     |  | _     | 0       |
| PPRWGS     |  | _     | 0       |
| PPSAT      |  | _     | 0       |
| PPSATCV    |  | _     | 0       |
| PPTWG      |  | _     | 0       |
| PPTWGR     |  | -     | 0       |
| PPTWGT     |  | -     | 0       |
| PPVAG      |  | -     | 0       |
| PQM        | Slope of normalized Tcen in inversion    | _     | 0.66    |
| PQMACC     | Slope of normalized Tcen in accumulation | _     | 0.66    |
| PQMFACTOR  |  | -     | 0       |
| PQMTCENCV  |  | _     | 0       |
| PQMTCENCVA |  | -     | 0       |
| PQMTCENIV  |  | _     | 0       |
| PRDDR      | Drain side quasi-saturation parameter    | -     | 0       |
| PRDSW      |  | -     | 0       |
| PRDW       |  | _     | 0       |
| PRSDEND    |  | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter   | Description   | Units | Default |
|-------------|---|-------|---------|
| PRSDR       | Source side quasi-saturation parameter                              | _     | 1       |
| PRSW        |   | _     | 0       |
| PRT         |   | _     | 0.001   |
| PRWGD       | Gate bias dependence of drain extension resistance,<br>Units:1/V    | _     | 0       |
| PRWGS       | Gate bias dependence of source extension resistance, Units:1/V      | _     | 0       |
| PSAT        | Velocity saturation exponent, after binnig should be from [2.0:inf) | _     | 2       |
| PSATCV      | Velocity saturation exponent for C-V                                | _     | 0       |
| PSEJ        | Source to substrate PN junction perimeter (BULKMOD=1)               | _     | 0       |
| PSEO        | Perimeter of source to substrate overlap region through oxide       | _     | 0       |
| PSII0       |   | _     | 0       |
| PSII1       |   | _     | 0       |
| PSII2       |   | _     | 0       |
| PSIID       |   | _     | 0       |
| PSTTHETASAT |   | _     | 0       |
| PTGIDL      |   | _     | 0       |
| PTII        |   | -     | 0       |
| PTSS        |   | _     | 0       |
| PTWG        | Gmsat degradation parameter - forward mode                          | _     | 0       |
| PTWGR       | Gmsat degradation parameter - reverse mode                          | _     | 0       |
| PTWGT       |   | -     | 0.004   |
| PU0         |   | _     | 0       |
| PU0R        |   | _     | 0       |
| PUA         |   | _     | 0       |
| PUA1        |   | _     | 0       |
| PUA1R       |   | _     | 0       |
| PUAR        |   | _     | 0       |
| PUC         |   | _     | 0       |
| PUC1        |   | _     | 0       |
| PUC1R       |   | _     | 0       |
| PUCR        |   | _     | 0       |
| PUCS        |   | _     | 0       |
| PUCSTE      |   | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| PUD       |  | _     | 0       |
| PUD1      |  | _     | 0       |
| PUD1R     |  | _     | 0       |
| PUDR      |  | _     | 0       |
| PUP       |  | _     | 0       |
| PUTE      |  | _     | 0       |
| PUTER     |  | _     | 0       |
| PUTL      |  | _     | 0       |
| PUTLR     |  | _     | 0       |
| PVAG      |  | _     | 1       |
| PVSAT     |  | _     | 0       |
| PVSAT1    |  | _     | 0       |
| PVSAT1R   |  | _     | 0       |
| PVSATCV   |  | _     | 0       |
| PVSATR    |  | _     | 0       |
| PWR       |  | _     | 0       |
| PXRCRG1   |  | _     | 0       |
| PXRCRG2   |  | _     | 0       |
| QM0       | Knee-Point for Tcen in inversion (Charge normalized to Cox)                        | -     | 0.001   |
| QM0ACC    | Knee-Point for Tcen in accumulation (Charge normalized to Cox)                     | -     | 0.001   |
| QMFACTOR  | Prefactor + switch for QM Vth correction   | _     | 0       |
| QMTCENCV  | Prefactor + switch for QM Width and Toxeff correction for CV                       | -     | 0       |
| QMTCENCVA | Prefactor + switch for QM Width and Toxeff correction for CV (accumulation region) | _     | 0       |
| QMTCENIV  | Prefactor + switch for QM Width correction for IV                                  | _     | 0       |
| RDDR      | Drain side drift resistance parameter - forward mode                               | _     | 0       |
| RDDRR     | Drain side drift resistance parameter - reverse mode                               | _     | 0       |
| RDSMOD    | Resistance model selector  | _     | 0       |
| RDSW      |  | _     | 100     |
| RDSWMIN   |  | _     | 0       |
| RDW       |  | _     | 50      |
| RDWMIN    |  | _     | 0       |
| RGATEMOD  | Gate electrode resistance on/off seector   | _     | 0       |
| RGEOA     | Fitting parameter for RGEOMOD=1  | _     | 1       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default |
|-----------|---|-------|---------|
| RGEOB     | Fitting parameter for RGEOMOD=1                                 | _     | 0       |
| RGEOC     | Fitting parameter for RGEOMOD=1                                 | _     | 0       |
| RGEOD     | Fitting parameter for RGEOMOD=1                                 | _     | 0       |
| RGEOE     | Fitting parameter for RGEOMOD=1                                 | _     | 0       |
| RGEOMOD   | Geometry-dependent source/drain resistance                      | _     | 0       |
| RGEXT     | Effective gate electrode external resistance                    | _     | 0       |
| RGFIN     | Effective gate electrode per finger per fin resistance          | _     | 0.001   |
| RHOC      |   | _     | 1e-12   |
| RHORSD    |   | _     | 1       |
| RNOIA     | Thermal noise coefficient                                       | _     | 0.577   |
| RNOIB     | Thermal noise coefficient                                       | _     | 0.37    |
| RNOIC     | Thermal noise coefficient for TNOIMOD=2                         | _     | 0.395   |
| RSDR      | Source side drift resistance parameter - forward mode           | _     | 0       |
| RSDRR     | Source side drift resistance parameter - reverse mode           | _     | 0       |
| RSHD      | Drain-side sheet resistance                                     | _     | 0       |
| RSHS      | Source-side sheet resistance                                    | _     | 0       |
| RSW       |   | _     | 50      |
| RSWMIN    |   | _     | 0       |
| RTH0      | Thermal resistance  | _     | 0.01    |
| SCALEN    |   | _     | 100000  |
| SDTERM    |   | _     | 0       |
| SHMOD     | Self heating and T node switcher — NOT USED IN XYCE             | _     | 0       |
| SIIO      | Vgs dependent parameter of Iii, 1/V                             | _     | 0.5     |
| SII1      | 1st Vgs dependent parameter of Iii, 1/V                         | _     | 0.1     |
| SII2      | 2nd Vgs dependent parameter of Iii                              | _     | 0       |
| SIID      | 3rd Vds dependent parameter of Iii, 1/V                         | _     | 0       |
| SJD       | Constant for drain-side two-step second junction                | _     | 0       |
| SJS       | Constant for source-side two-step second junction               | _     | 0       |
| SJSWD     | Constant for drain-side sidewall two-step second junction       | -     | 0       |
| SJSWGD    | Constant for source-side gate sidewall two-step second junction | -     | 0       |
| SJSWGS    | Constant for source-side gate sidewall two-step second junction | -     | 0       |
| SJSWS     | Constant for source-side sidewall two-step second junction      | _     | 0       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| TBGASUB   | Bandgap Temperature Coefficient (eV / degrees)  | _     | 0.000702 |
| TBGBSUB   | Bandgap Temperature Coefficient (degrees)   | _     | 1108     |
| TCJ       | Temperature coefficient for CJS/CJD   | _     | 0        |
| TCJSW     | Temperature coefficient for CJSWS/CJSWD   | _     | 0        |
| TCJSWG    | Temperature coefficient for CJSWGS/CJSWGD   | _     | 0        |
| TEMPMOD   |   | _     | 0        |
| TETA0     | Temperature dependence of DIBL coefficient, 1/K   | _     | 0        |
| TETAOR    | Temperature dependence of Reverse-mode DIBL coefficient, 1/K                                  | _     | 0        |
| TFIN      | Body (Fin) thickness  | _     | 1.5e-08  |
| TGATE     | Gate height on top of the hard mask   | _     | 3e-08    |
| TGIDL     | GIDL/GISL Temperature Dependence  | _     | -0.003   |
| THETADIBL | DIBL length dependence. If defined by user, will overwrite Theta_DIBL in the code             | _     | 0        |
| THETASCE  | Vth roll-off length dependence. If defined by user, will overwrite Theta_SCE in the code      | _     | 0        |
| THETASW   | Subthreshold Swing length dependence. If defined by user, will overwrite Theta_SW in the code | _     | 0        |
| TII       | Impact Ionization Temperature Dependence, IIMOD=2   | _     | 0        |
| TMASK     | Height of hard mask on top of the fin   | _     | 3e-08    |
| TMEXP     |   | _     | 0        |
| TMEXPR    |   | _     | 0        |
| TNJTS     | Temperature coefficient for NJTS  | _     | 0        |
| TNJTSD    | Temperature coefficient for NJTSD   | _     | 0        |
| TNJTSSW   | Temperature coefficient for NJTSSW  | _     | 0        |
| TNJTSSWD  | NTemperature coefficient for NJTSSWD  |       | 0        |
| TNJTSSWG  | Temperature coefficient for NJTSSWG   |       | 0        |
| TNJTSSWGD | Temperature coefficient for NJTSSWGD  |       | 0        |
| TNOIA     | Thermal noise parameter   | _     | 1.5      |
| TNOIB     | Thermal noise parameter   |       | 3.5      |
| TNOIC     | Thermal noise parameter for TNOIMOD=2   | _     | 3.5      |
| TNOIMOD   | 0: charge based, 1: holistic thermal noise based on BSIM4 noise model                         | _     | 0        |
| TNOM      | Temperature at which the model is extracted (degrees)   | _     | 27       |
| TOXG      | oxide thickness for gate current model in meters,<br>Introduced in BSIM-CMG106.1.0            | _     | 0        |
| TOXP      | physical oxide thickness in meters  | _     | 1.2e-09  |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description   | Units | Default   |
|-----------|---|-------|-----------|
| TOXREF    | Target tox value [m]  | -     | 1.2e-09   |
| TPB       | Temperature coefficient for PBS/PBD                           | _     | 0         |
| TPBSW     | Temperature coefficient for PBSWS/PBSWD                       | _     | 0         |
| TPBSWG    | Temperature coefficient for PBSWGS/PBSWGD                     | _     | 0         |
| TRDDR     |   | _     | 0         |
| TRSDR     |   | _     | 0         |
| TSILI     | Thickness of the silicide on top of the raised source/drain   | _     | 1e-08     |
| TSS       | SSwing Temperature Coefficient (/ degrees)                    | _     | 0         |
| TYPE      |   | _     | 0         |
| U0        |   | _     | 0.03      |
| U0MULT    | Variability in carrier mobility                               | _     | 1         |
| UON1      | NFIN dependence of U0   | _     | 0         |
| U0N1R     |   | -     | 0         |
| U0N2      | NFIN dependence of U0   | -     | 100000    |
| U0N2R     |   | _     | 0         |
| U0R       |   | _     | 0         |
| UA        |   | _     | 0.3       |
| UA1       |   | _     | 0.001032  |
| UA1R      |   | -     | 0         |
| UAR       |   | -     | 0         |
| UC        | Body effect for mobility degradation parameter -<br>BULKMOD=1 | -     | 0         |
| UC1       |   | -     | 5.6e-11   |
| UC1R      |   | _     | 0         |
| UCR       |   | _     | 0         |
| UCS       |   | _     | 1         |
| UCSTE     |   | _     | -0.004775 |
| UD        |   | _     | 0         |
| UD1       |   | _     | 0         |
| UD1R      |   | _     | 0         |
| UDR       |   | _     | 0         |
| UP        |   | _     | 0         |
| UPR       |   | _     | 0         |
| UTE       |   | _     | 0         |
| UTER      |   | _     | 0         |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| UTL       |  | _     | -0.0015 |
| UTLR      |  | _     | 0       |
| VSAT      |  | _     | 85000   |
| VSAT1     | Velocity Saturation parameter for I_on degradation - forward mode                                    | -     | 0       |
| VSAT1N1   | NFIN dependence of VSAT1   | _     | 0       |
| VSAT1N2   | NFIN dependence of VSAT1   | _     | 0       |
| VSAT1R    | Velocity Saturation parameter for I_on degradation - reverse mode                                    | _     | 0       |
| VSAT1RN1  | NFIN dependence of VSAT1R  | _     | 0       |
| VSAT1RN2  | NFIN dependence of VSAT1R  | _     | 0       |
| VSATCV    | Velocity Saturation parameter for CV   | _     | 0       |
| VSATN1    | NFIN dependence of VSAT  | _     | 0       |
| VSATN2    | NFIN dependence of VSAT  | _     | 100000  |
| VSATR     |  | _     | 0       |
| VSATRN1   | NFIN dependence of VSATR   | _     | 0       |
| VSATRN2   | NFIN dependence of VSATR   | _     | 0       |
| VTSD      | Bottom drain junction trap-assisted current voltage dependent parameter                              | _     | 0       |
| VTSS      | Bottom source junction trap-assisted current voltage dependent parameter                             | _     | 10      |
| VTSSWD    | Unit length trap-assisted current voltage dependent parameter for sidewall drain junction            | _     | 0       |
| VTSSWGD   | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall drain junction  | _     | 0       |
| VTSSWGS   | Unit length trap-assisted current voltage dependent parameter for gate-edge sidewall source junction | _     | 10      |
| VTSSWS    | Unit length trap-assisted current voltage dependent parameter for sidewall source junction           | _     | 10      |
| WR        |  | _     | 1       |
| WTH0      | Width dependence coefficient for Rth and Cth   | _     | 0       |
| XJBVD     | Fitting parameter for drain diode breakdown current  | _     | 0       |
| XJBVS     | Fitting parameter for source diode breakdown current   | _     | 1       |
| XL        | L offset for channel length due to mask/etch effect  | _     | 0       |
| XRCRG1    |  | _     | 12      |
| XRCRG2    |  | _     | 1       |
| XTID      | Drain junction current temperature exponent  | _     | 0       |
| XTIS      | Source junction current temperature exponent   | _     | 3       |

Table 2-131. BSIM-CMG FINFET v108.0.0 Device Model Parameters

| Parameter | Description                                | Units | Default |
|-----------|--|-------|---------|
| XTSD      | Power dependence of JTSD on temperature    | _     | 0       |
| XTSS      | Power dependence of JTSS on temperature    | _     | 0.02    |
| XTSSWD    | Power dependence of JTSSWD on temperature  | -     | 0       |
| XTSSWGD   | Power dependence of JTSSWGD on temperature | _     | 0       |
| XTSSWGS   | Power dependence of JTSSWGS on temperature | _     | 0.02    |
| XTSSWS    | Power dependence of JTSSWS on temperature  | _     | 0.02    |

Table 2-132. MOSFET level 108 Output Variables

| LEFF         LEFFCV         -         none           MEFFCV         LEFFCV         -         none           LEFFCV         LEFFCV         -         none           LDS         IDS         -         none           LDEFF         IDEFF         -         none           LSEFF         ISEFF         -         none           LGTOT         IGTOT         -         none           LISESEN         IDSGEN         -         none           LISI         III         -         none           LIGIDL         IGIDL         -         none           LIGISL         IGISL         -         none           LIJBB         IJDB         -         none           LIJBB         IJDB         -         none           LISUB         ISUB         -         none           LEFFCV         ISUB         -         none           LIJBB         IJDB         -         none           LIJBB         ISUB         -         none           LIJBB         ISUB         -         none           LIJBB         ISUB         -         none           LOTH   | Parameter | Description | Units | Default |
|--|-----------|-------------|-------|---------|
| MEFFCV         WEFFCV         -         none           LEFFCV         LEFFCV         -         none           LDS         IDS         -         none           LDEFF         IDEFF         -         none           LISEFF         ISEFF         -         none           LIGTOT         -         none         IDEGEN         -         none           LILI         III         -         none         IDEGEN         -         none         IDEGEN | WEFF      | WEFF        | -     | none    |
| LEFFCV         LEFFCV         -         none           IDS         -         none           IDEFF         IDEFF         -         none           ISEFF         ISEFF         -         none           IGTOT         -         none           IBSGEN         IDSGEN         -         none           IUI         III         -         none           IGIDL         -         none         -           IGISL         IGISL         -         none           IJDB         IJDB         -         none           ISUB         ISUB         -         none           ISUB         ISUB         -         none           VTH         VTH         -         none           VFB         VFB         -         none           ISUB         GM         -         none           VFB         VFB         -         none           ISUB         -         none         -           VFB         -         none         -           ISUB         -         none         -           ISUB         -         none         - <t< td=""><td>LEFF</td><td>LEFF</td><td>-</td><td>none</td></t<>  | LEFF      | LEFF        | -     | none    |
| IDS  | WEFFCV    | WEFFCV      | _     | none    |
| IDEFF  | LEFFCV    | LEFFCV      | _     | none    |
| ISEFF  | IDS       | IDS         | _     | none    |
| IGTOT  | IDEFF     | IDEFF       | -     | none    |
| IDSGEN   IDSGEN   -  | ISEFF     | ISEFF       | _     | none    |
| III  | IGTOT     | IGTOT       | _     | none    |
| IGIDL         IGIDL         -         none           IGISL         IGISL         -         none           IJSB         IJSB         -         none           IJDB         IJDB         -         none           ISUB         -         none           BETA         BETA         -         none           VTH         VTH         -         none           VFB         VFB         -         none           GM         -         none           GMSS         -         none           QGI         -         none           QDI         -         none           QSI         -         none  | IDSGEN    | IDSGEN      | _     | none    |
| IGISL         IGISL         -         none           IJSB         IJSB         -         none           IJDB         IJDB         -         none           ISUB         -         none           BETA         -         none           VTH         VTH         -         none           VDSSAT         VDSSAT         -         none           GM         GM         -         none           GDS         GN         -         none           GMBS         -         none           QGI         -         none           QDI         -         none           QSI         QSI         -         none   | III       | III         | _     | none    |
| IJSB         IJSB         - none           IJDB         IJDB         - none           ISUB         ISUB         - none           BETA         BETA         - none           VTH         VTH         - none           VDSSAT         VDSSAT         - none           VFB         VFB         - none           GM         - none         GMS           GDS         - none           GMBS         - none           QGI         - none           QDI         - none           QDI         - none           QSI         QSI   | IGIDL     | IGIDL       | _     | none    |
| IJDB         IJDB         - none           ISUB         ISUB         - none           BETA         BETA         - none           VTH         VTH         - none           VDSSAT         VDSSAT         - none           VFB         - none         - none           GM         - none         - none           GDS         - none         - none           GMBS         - none         - none           QGI         - none         - none           QDI         - none         - none           QSI         - none         - none   | IGISL     | IGISL       | _     | none    |
| ISUB         ISUB         -         none           BETA         -         none           VTH         VTH         -         none           VDSSAT         VDSSAT         -         none           VFB         VFB         -         none           GM         -         none           GDS         -         none           GMBS         -         none           QGI         -         none           QDI         -         none           QSI         -         none  | IJSB      | IJSB        | _     | none    |
| BETA         BETA         -         none           VTH         VTH         -         none           VDSSAT         VDSSAT         -         none           VFB         VFB         -         none           GM         -         none           GDS         -         none           GMBS         -         none           QGI         -         none           QDI         -         none           QSI         -         none  | IJDB      | IJDB        | _     | none    |
| VTH         VTH         -         none           VDSSAT         VDSSAT         -         none           VFB         VFB         -         none           GM         -         none           GDS         -         none           GMBS         -         none           QGI         -         none           QDI         -         none           QSI         -         none   | ISUB      | ISUB        | _     | none    |
| VDSSAT         VDSSAT         - none           VFB         VFB         - none           GM         - none           GDS         - none           GMBS         - none           QGI         QGI         - none           QDI         - none           QSI         QSI         - none  | BETA      | BETA        | _     | none    |
| VFB         VFB         -         none           GM         -         none           GDS         -         none           GMBS         -         none           QGI         QGI         -         none           QDI         -         none           QSI         QSI         -         none   | VTH       | VTH         | _     | none    |
| GM         -         none           GDS         -         none           GMBS         -         none           QGI         QGI         -         none           QDI         -         none           QSI         QSI         -         none  | VDSSAT    | VDSSAT      |       | none    |
| GDS         GDS         -         none           GMBS         -         none           QGI         QGI         -         none           QDI         -         none           QSI         QSI         -         none  | VFB       | VFB         |       | none    |
| GMBS GMBS - none QGI QGI - none QDI - none QSI QSI - none  | GM        | GM          | _     | none    |
| QGI         QGI         -         none           QDI         -         none           QSI         -         none   | GDS       | GDS         |       | none    |
| QDI — none QSI — none  | GMBS      | GMBS        | _     | none    |
| QSI — none   | QGI       | QGI         |       | none    |
|  | QDI       | QDI         |       | none    |
| QBI — none   | QSI       | QSI         | _     | none    |
|  | QBI       | QBI         | -     | none    |

Table 2-132. MOSFET level 108 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| QG        | QG          | -     | none    |
| QD        | QD          | _     | none    |
| QS        | QS          | _     | none    |
| QB        | QB          | _     | none    |
| CGGI      | CGGI        | _     | none    |
| CGSI      | CGSI        | _     | none    |
| CGDI      | CGDI        | _     | none    |
| CGEI      | CGEI        | _     | none    |
| CDGI      | CDGI        | _     | none    |
| CDDI      | CDDI        | _     | none    |
| CDSI      | CDSI        | _     | none    |
| CDEI      | CDEI        | -     | none    |
| CSGI      | CSGI        | _     | none    |
| CSDI      | CSDI        | _     | none    |
| CSSI      | CSSI        | _     | none    |
| CSEI      | CSEI        | _     | none    |
| CEGI      | CEGI        | _     | none    |
| CEDI      | CEDI        | _     | none    |
| CESI      | CESI        | _     | none    |
| CEEI      | CEEI        | _     | none    |
| CGG       | CGG         | _     | none    |
| CGS       | CGS         | _     | none    |
| CGD       | CGD         | _     | none    |
| CGE       | CGE         | _     | none    |
| CDG       | CDG         | _     | none    |
| CDD       | CDD         | _     | none    |
| CDS       | CDS         | _     | none    |
| CDE       | CDE         | _     | none    |
| CSG       | CSG         | -     | none    |
| CSD       | CSD         | _     | none    |
| CSS       | CSS         | _     | none    |
| CSE       | CSE         | -     | none    |
| CEG       | CEG         | -     | none    |
| CED       | CED         | _     | none    |
| CES       | CES         | -     | none    |
| CEE       | CEE         | _     | none    |

Table 2-132. MOSFET level 108 Output Variables

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| CGSEXT    | CGSEXT      | _     | none    |
| CGDEXT    | CGDEXT      | _     | none    |
| CGBOV     | CGBOV       | _     | none    |
| CJST      | CJST        | _     | none    |
| CJDT      | CJDT        | _     | none    |
| RSGEO     | RSGEO       | _     | none    |
| RDGEO     | RDGEO       | _     | none    |
| CFGEO     | CFGEO       | _     | none    |
| TDEVICE   | TDEVICE     | _     | none    |

## 2.3.20.15. Levels 2000 and 2001 MOSFET Tables (MVS version 2.0.0)

Xyce includes the MIT Virtual Source (MVS) MOSFET model version 2.0.0 in both ETSOI and HEMT variants. The code in Xyce was generated from the MIT Verilog-A input. Model parameters for the MVS model are given in 2-133 and 2-134. The MVS model does not have instance parameters. Details of the model are documented MVS Nanotransistor Model 2.0.0 manual, available from the NEEDS web site at https://nanohub.org/publications/74/1.

**NOTE:** Unlike all other MOSFET models in Xyce, the MVS model takes only 3 nodes, the drain, gate and source. It takes no substrate node.

Table 2-133. MVS ETSOI 2.0.0 Device Model Parameters

| Parameter        | Description | Units | Default  |
|------------------|-------------|-------|----------|
| В                |             | -     | 6.8e-09  |
| BETA             |             | _     | 1.55     |
| CINS             |             | _     | 0.0317   |
| DELTA            |             | _     | 0.12     |
| DLG              |             | _     | 1.05e-08 |
| DQM0             |             | _     | 4.6e-09  |
| ENERGY_DIFF_VOLT |             | _     | 0.153    |
| EPS              |             | _     | 13.6     |
| KSEE             |             | _     | 0.1      |
| LGDR             |             | _     | 8e-08    |
| ML               |             | _     | 0.89     |
| MT               |             | _     | 0.19     |
| MU_EFF           |             | _     | 1        |
| N0               |             | _     | 1.35     |
| ND               |             | _     | 0        |
| NU               |             | _     | 0.7      |
| RS0              |             | _     | 0.00016  |
| THETA            |             | _     | 2.5      |
| TJUN             |             | _     | 300      |
| TYPE             |             | _     | 1        |
| VERSION          |             | _     | 2        |
| W                |             | _     | 1e-06    |

Table 2-134. MVS HEMT 2.0.0 Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| В         |             | -     | 6.8e-09 |
| BETA      |             | _     | 1.55    |

Table 2-134. MVS HEMT 2.0.0 Device Model Parameters

| Parameter        | Description | Units | Default  |
|------------------|-------------|-------|----------|
| CINS             |             | -     | 0.0317   |
| DELTA            |             | _     | 0.12     |
| DLG              |             | _     | 1.05e-08 |
| DQM0             |             | _     | 4.6e-09  |
| ENERGY_DIFF_VOLT |             | _     | 0.153    |
| EPS              |             | _     | 13.6     |
| KSEE             |             | _     | 0.1      |
| LGDR             |             | _     | 8e-08    |
| MEFF             |             | _     | 0.041    |
| MU_EFF           |             | _     | 1        |
| NO               |             | _     | 1.35     |
| NACC             |             | _     | 2.25e+16 |
| ND               |             | _     | 0        |
| NP_MASS          |             | _     | 9        |
| RC0              |             | -     | 0.00016  |
| THETA            |             | _     | 2.5      |
| TJUN             |             | _     | 300      |
| TYPE             |             | _     | 1        |
| VERSION          |             | _     | 2        |
| W                |             | _     | 1e-06    |

## 2.3.20.16. Level 2002 MOSFET Tables (MVSG\_CMC version 1.1.0)

Xyce includes the MIT Virtual Source GaN HEMT High-Voltage (MVSG\_CMC) MOSFET model version 1.1.0. The code in Xyce was generated from the MIT Verilog-A input. Model parameters for the MVS model are given in 2-135 and 2-136, and its output variables in 2-137. More information about this model may be obtained from the CMC standard models page at https://si2.org/standard-models.

Table 2-135. MVSG-HV HEMT MODEL Device Instance Parameters

| Parameter | Description                            | Units | Default |
|-----------|--|-------|---------|
| DTEMP     | Device temperature offset from ambient | K     | 0       |
| L         | Effective gate length                  | m     | 2.5e-07 |
| NGF       | Number of Fingers                      | _     | 2       |
| W         | Width per Finger                       | m     | 0.00018 |

Table 2-136. MVSG-HV HEMT MODEL Device Model Parameters

| Parameter | Description                                    | Units | Default |
|-----------|--|-------|---------|
| AF        | Flicker noise exponent                         | _     | 2       |
| ALPHA     | Weak to strong inversion transition factor     | _     | 3.5     |
| ALPHAFP1  | FP weak to strong inversion transition factor  | _     | 0.01    |
| ALPHAFP2  | FP weak to strong inversion transition factor  | _     | 0.01    |
| ALPHAFP3  | FP weak to strong inversion transition factor  | _     | 0.01    |
| ALPHAFP4  | FP weak to strong inversion transition factor  | _     | 0.01    |
| ALPHAGD   | G-D high injection smoothing parameter         | _     | 10      |
| ALPHAGS   | G-S high injection smoothing parameter         | _     | 10      |
| ALPHARD   | DAR weak to strong inversion transition factor | _     | 3.5     |
| ALPHARS   | SAR weak to strong inversion transition factor | _     | 3.5     |
| ALPHAT1   | Trap coefficient 1 on bias stress              | _     | 0.0001  |
| ALPHAT2   | Trap coefficient 2 on bias stress              | V     | 21      |
| BETA      | Linear to saturation parameter                 | _     | 1.5     |
| BETAFP1   | FP linear to saturation parameter              | _     | 1       |
| BETAFP2   | FP linear to saturation parameter              | _     | 1       |
| BETAFP3   | FP linear to saturation parameter              | _     | 1       |
| BETAFP4   | FP linear to saturation parameter              | _     | 1       |
| BETARD    | DAR linear to saturation parameter             | _     | 1       |
| BETARECD  | G-D linear to saturation parameter             | _     | 0.25    |
| BETARECS  | G-S linear to saturation parameter             | _     | 2       |
| BETARS    | SAR linear to saturation parameter             | _     | 1       |
| CBFP1     | Body to drain (under FP) cap/width             | _     | 0       |
| CBFP2     | Body to drain (under FP) cap/width             | _     | 0       |

Table 2-136. MVSG-HV HEMT MODEL Device Model Parameters

| CBFP3         Body to drain (under FP) cap/width         —         0           CBFP4         Body to drain (under FP) cap/width         —         0           CCFP1         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP2         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP3         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source or gate to drain (under FP) cap/width         —         1e-19           CCFP4         FP (source-side) to source cap/width         —         1e-19           CCFP2         FP (source-side) to source cap/width         —         1e-19           CCFP3         FP (source-side) to source cap/width         —         1e-19           CCFP4         FP (source-side) to source cap/width         —         1e-19           CGF         Gate cap/area         —         0.0002           CGFP1         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.003   | Parameter | Description                                  | Units | Default |
|---|-----------|--|-------|---------|
| CCFP1         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP2         Source or gate to drain (under FP) cap/width         —         3e-11           CCFP3         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source cap to drain (under FP) cap/width         —         1e-19           CFP1S         FP (source-side) to source cap/width         —         1e-19           CFP2S         FP (source-side) to source cap/width         —         1e-19           CFP3S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CGF         Gate cap/area         —         0.004           CGFP1         FP gate-cap/area         —         0.0002           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.0002           CGFD4         FP gate-cap/area         —         0.0043           CGFB         Gate observable   | CBFP3     | Body to drain (under FP) cap/width           | _     | 0       |
| CCFP2         Source or gate to drain (under FP) cap/width         —         3e-11           CCFP3         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source or gate to drain (under FP) cap/width         —         9e-11           CFP18         FP (source-side) to source cap/width         —         1e-19           CFP28         FP (source-side) to source cap/width         —         1e-19           CFP3S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CFP4         FP (source-side) to source cap/width         —         1e-19           CG         Gate cap/area         —         0.004           CGF         Gate cap/area         —         0.0002           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.005           COFDM         Gate- Drain outer fringing cap/wid   | CBFP4     | Body to drain (under FP) cap/width           | _     | 0       |
| CCFP3         Source or gate to drain (under FP) cap/width         —         9e-11           CCFP4         Source or gate to drain (under FP) cap/width         —         9e-11           CFP1S         FP (source-side) to source cap/width         —         1e-19           CFP2S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CG         Gate cap/area         —         0.004           CGF         Gate cap/area         —         0.0002           CGFP1         FP gate-cap/area         —         0.0001           CGFP2         FP gate-cap/area         —         0.0002           CGFP3         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.0043           CGFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Sub - Drain outer fringing cap/width         —         1e-10           COFESUBM         Sub - Source outer fringing cap/width <td< td=""><td>CCFP1</td><td>Source or gate to drain (under FP) cap/width</td><td>_</td><td>9e-11</td></td<> | CCFP1     | Source or gate to drain (under FP) cap/width | _     | 9e-11   |
| CCFP4         Source or gate to drain (under FP) cap/width         —         9e-11           CFP1S         FP (source-side) to source cap/width         —         1e-19           CFP2S         FP (source-side) to source cap/width         —         1e-19           CFP3S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CGP         Gate cap/area         —         0.004           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0002           CGFP3         FP gate-cap/area         —         0.0002           CGFD4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0005           CGRD         DAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Source - Drain outer fringing cap/width         —         0           COFSSUBM         Sub - Source outer fringing cap/width         —  | CCFP2     | Source or gate to drain (under FP) cap/width | _     | 3e-11   |
| CFP1S         FP (source-side) to source cap/width         —         1e-19           CFP2S         FP (source-side) to source cap/width         —         1e-19           CFP3S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CGF         Gate cap/area         —         0.0004           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0002           CGFP3         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDM         Gate - Drain outer fringing cap/width         —         0           COFGSUBM         Sub - Gate outer fringing cap/width         —         0 <td>CCFP3</td> <td>Source or gate to drain (under FP) cap/width</td> <td>_</td> <td>9e-11</td>                              | CCFP3     | Source or gate to drain (under FP) cap/width | _     | 9e-11   |
| CFF2S         FP (source-side) to source cap/width         —         1e-19           CFF3S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CG         Gate cap/area         —         0.0004           CGFP1         FP gate-cap/area         —         0.0001           CGFP2         FP gate-cap/area         —         0.0002           CGFP3         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           CGFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFGSUBM         Sub - Drain outer fringing cap/width         —         1e-10           COFSSUEM         Sub - Source outer fringing cap/width         —         1e-09           COFSSUEM         Sub - Source outer fringing cap/width         —         1e-09           COFSSUEM         Sub - Source outer fringing cap/width   | CCFP4     | Source or gate to drain (under FP) cap/width | _     | 9e-11   |
| CFF3S         FP (source-side) to source cap/width         —         1e-19           CFP4S         FP (source-side) to source cap/width         —         1e-19           CG         Gate cap/area         —         0.004           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0001           CGFP3         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         1e-10           COFSSUBM         Sub - Gate outer fringing cap/width         —         0           COFSSUBM         Sub - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001<   | CFP1S     | FP (source-side) to source cap/width         | _     | 1e-19   |
| CFF4S         FP (source-side) to source cap/width         —         1e-19           CG         Gate cap/area         —         0.004           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0001           CGFP3         FP gate-cap/area         —         0.0002           CGFD4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         1e-10           COFSSUBM         Sub - Source outer fringing cap/width         —         0           COFSSUBM         Sub - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001  | CFP2S     | FP (source-side) to source cap/width         | _     | 1e-19   |
| CG         Gate cap/area         —         0.004           CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0001           CGFP3         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         1e-10           COFSSUBM         Sub - Gate outer fringing cap/width         —         0           COFSSUBM         Gate - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001 <td>CFP3S</td> <td>FP (source-side) to source cap/width</td> <td>_</td> <td>1e-19</td>                                      | CFP3S     | FP (source-side) to source cap/width         | _     | 1e-19   |
| CGFP1         FP gate-cap/area         —         0.0002           CGFP2         FP gate-cap/area         —         0.0001           CGFP3         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFSSUEM         Sub - Gate outer fringing cap/width         —         0           COFSSUEM         Sub - Source outer fringing cap/width         —         1e-09           COFSSUEM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0           DELTA1FP2         FP DIBL Coefficient         —         0 <t< td=""><td>CFP4S</td><td>FP (source-side) to source cap/width</td><td>_</td><td>1e-19</td></t<>   | CFP4S     | FP (source-side) to source cap/width         | _     | 1e-19   |
| CGFP2         FP gate-cap/area         —         0.0001           CGFP3         FP gate-cap/area         —         0.0002           CGFP4         FP gate-cap/area         —         0.0003           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         0           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFSSUBM         Sub - Gate outer fringing cap/width         —         0           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient         —         0           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1RD         <  | CG        | Gate cap/area                                | _     | 0.004   |
| CGFF3         FP gate-cap/area         — 0.0002           CGFP4         FP gate-cap/area         — 0.0002           CGRD         DAR gate-cap/area         — 0.0043           CGRS         SAR gate-cap/area         — 0.005           COFDM         Gate - Drain outer fringing cap/width         — 1e-10           COFDSM         Source - Drain outer fringing cap/width         — 0           COFDSUBM         Sub - Drain outer fringing cap/width         — 0           COFGSUBM         Sub - Gate outer fringing cap/width         — 0           COFSSM         Gate - Source outer fringing cap/width         — 1e-09           COFSSUBM         Sub - Source outer fringing cap/width         — 0           CTH         Thermal capacitance         — 0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         — 0.016           DELTA1FP1         FP DIBL Coefficient         — 0           DELTA1FP2         FP DIBL Coefficient         — 0           DELTA1FP3         FP DIBL Coefficient         — 0           DELTA1RB         DAR DIBL Coefficient         — 0           DELTA1RB         SAR DIBL Coefficient         — 0.35           DELTA1RB         SAR DIBL Coef   | CGFP1     | FP gate-cap/area                             | _     | 0.0002  |
| CGFP4         FP gate-cap/area         —         0.0002           CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         0           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFSUBM         Sub - Gate outer fringing cap/width         —         0           COFSM         Gate - Source outer fringing cap/width         —         0           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient I         —         0           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35  | CGFP2     | FP gate-cap/area                             | _     | 0.0001  |
| CGRD         DAR gate-cap/area         —         0.0043           CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFGSUBM         Sub - Gate outer fringing cap/width         —         0           COFSM         Gate - Source outer fringing cap/width         —         0           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1   | CGFP3     | FP gate-cap/area                             | _     | 0.0002  |
| CGRS         SAR gate-cap/area         —         0.005           COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFGSUBM         Sub - Gate outer fringing cap/width         —         0           COFSM         Gate - Source outer fringing cap/width         —         0.000           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Coefficient 2         —         0 <t< td=""><td>CGFP4</td><td>FP gate-cap/area</td><td>_</td><td>0.0002</td></t<>   | CGFP4     | FP gate-cap/area                             | _     | 0.0002  |
| COFDM         Gate - Drain outer fringing cap/width         —         1e-10           COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFGSUBM         Sub - Gate outer fringing cap/width         —         0           COFSM         Gate - Source outer fringing cap/width         —         0.000           COFS SUBM         Sub - Source outer fringing cap/width         —         0.0001           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1RP4         FP DIBL Coefficient         —         0           DELTA1RS         SAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient 2         —         0           DIBSAT         DIBL Saturation Voltage         V         10  | CGRD      | DAR gate-cap/area                            | _     | 0.0043  |
| COFDSM         Source - Drain outer fringing cap/width         —         1e-10           COFDSUBM         Sub - Drain outer fringing cap/width         —         0           COFGSUBM         Sub - Gate outer fringing cap/width         —         0           COFSM         Gate - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1FP4         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Saturation Voltage         V         10           EPSILON         Mobility dependence on temperature         —         2.3   | CGRS      | SAR gate-cap/area                            | _     | 0.005   |
| COFDSUBM Sub - Drain outer fringing cap/width — 0 COFGSUBM Sub - Gate outer fringing cap/width — 1e-09 COFSM Gate - Source outer fringing cap/width — 1e-09 COFSSUBM Sub - Source outer fringing cap/width — 0 CTH Thermal capacitance — 0.0001 CTRAP DC-block capacitor F 0.001 DELTA1 DIBL Coefficient 1 — 0.016 DELTA1FP1 FP DIBL Coefficient — 0 DELTA1FP2 FP DIBL Coefficient — 0 DELTA1FP3 FP DIBL Coefficient — 0 DELTA1FP4 FP DIBL Coefficient — 0 DELTA1RD DAR DIBL Coefficient — 0.35 DELTA1RS SAR DIBL Coefficient — 0.1 DELTA2 DIBL Coefficient — 0.1 DELTA2 DIBL Coefficient — 0.1 DELTA2 DIBL Coefficient — 0.2 DIBL Coefficient — 0.35 DELTA1RS SAR DIBL Coefficient — 0.1 DELTA2 DIBL Coefficient — 0.2 DIBL Saturation Voltage V 10 EPSILON Mobility dependence on temperature — 2.3   | COFDM     | Gate - Drain outer fringing cap/width        | _     | 1e-10   |
| COFGSUBM         Sub - Gate outer fringing cap/width         —         0           COFSM         Gate - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1FP4         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Coefficient 2         —         0           DIBSAT         DIBL saturation Voltage         V         10           EPSILON         Mobility dependence on temperature         —         2.3  | COFDSM    | Source - Drain outer fringing cap/width      | _     | 1e-10   |
| COFSM         Gate - Source outer fringing cap/width         —         1e-09           COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient I         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1FP4         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Coefficient 2         —         0           DIBSAT         DIBL saturation Voltage         V         10           EPSILON         Mobility dependence on temperature         —         2.3   | COFDSUBM  | Sub - Drain outer fringing cap/width         | _     | 0       |
| COFSSUBM         Sub - Source outer fringing cap/width         —         0           CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1FP4         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Coefficient 2         —         0           DIBSAT         DIBL saturation Voltage         V         10           EPSILON         Mobility dependence on temperature         —         2.3  | COFGSUBM  | Sub - Gate outer fringing cap/width          | _     | 0       |
| CTH         Thermal capacitance         —         0.0001           CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1FP4         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Coefficient 2         —         0           DIBSAT         DIBL saturation Voltage         V         10           EPSILON         Mobility dependence on temperature         —         2.3   | COFSM     | Gate - Source outer fringing cap/width       | _     | 1e-09   |
| CTRAP         DC-block capacitor         F         0.001           DELTA1         DIBL Coefficient 1         —         0.016           DELTA1FP1         FP DIBL Coefficient         —         0           DELTA1FP2         FP DIBL Coefficient         —         0           DELTA1FP3         FP DIBL Coefficient         —         0           DELTA1FP4         FP DIBL Coefficient         —         0           DELTA1RD         DAR DIBL Coefficient         —         0.35           DELTA1RS         SAR DIBL Coefficient         —         0.1           DELTA2         DIBL Coefficient 2         —         0           DIBSAT         DIBL saturation Voltage         V         10           EPSILON         Mobility dependence on temperature         —         2.3  | COFSSUBM  | Sub - Source outer fringing cap/width        | _     | 0       |
| DELTA1 DIBL Coefficient 1 — 0.016  DELTA1FP1 FP DIBL Coefficient — 0  DELTA1FP2 FP DIBL Coefficient — 0  DELTA1FP3 FP DIBL Coefficient — 0  DELTA1FP4 FP DIBL Coefficient — 0  DELTA1RD DAR DIBL Coefficient — 0.35  DELTA1RS SAR DIBL Coefficient — 0.1  DELTA2 DIBL Coefficient 2 — 0  DIBSAT DIBL saturation Voltage V 10  EPSILON Mobility dependence on temperature — 2.3  | СТН       | Thermal capacitance                          | _     | 0.0001  |
| DELTA1FP1FP DIBL Coefficient—0DELTA1FP2FP DIBL Coefficient—0DELTA1FP3FP DIBL Coefficient—0DELTA1FP4FP DIBL Coefficient—0DELTA1RDDAR DIBL Coefficient—0.35DELTA1RSSAR DIBL Coefficient—0.1DELTA2DIBL Coefficient 2—0DIBSATDIBL saturation VoltageV10EPSILONMobility dependence on temperature—2.3  | CTRAP     | DC-block capacitor                           | F     | 0.001   |
| DELTA1FP2FP DIBL Coefficient—0DELTA1FP3FP DIBL Coefficient—0DELTA1FP4FP DIBL Coefficient—0DELTA1RDDAR DIBL Coefficient—0.35DELTA1RSSAR DIBL Coefficient—0.1DELTA2DIBL Coefficient 2—0DIBSATDIBL saturation VoltageV10EPSILONMobility dependence on temperature—2.3  | DELTA1    | DIBL Coefficient 1                           | _     | 0.016   |
| DELTA1FP3FP DIBL Coefficient—0DELTA1FP4FP DIBL Coefficient—0DELTA1RDDAR DIBL Coefficient—0.35DELTA1RSSAR DIBL Coefficient—0.1DELTA2DIBL Coefficient 2—0DIBSATDIBL saturation VoltageV10EPSILONMobility dependence on temperature—2.3  | DELTA1FP1 | FP DIBL Coefficient                          | _     | 0       |
| DELTA1FP4FP DIBL Coefficient—0DELTA1RDDAR DIBL Coefficient—0.35DELTA1RSSAR DIBL Coefficient—0.1DELTA2DIBL Coefficient 2—0DIBSATDIBL saturation VoltageV10EPSILONMobility dependence on temperature—2.3  | DELTA1FP2 | FP DIBL Coefficient                          | _     | 0       |
| DELTA1RDDAR DIBL Coefficient—0.35DELTA1RSSAR DIBL Coefficient—0.1DELTA2DIBL Coefficient 2—0DIBSATDIBL saturation VoltageV10EPSILONMobility dependence on temperature—2.3  | DELTA1FP3 | FP DIBL Coefficient                          | _     | 0       |
| DELTA1RS     SAR DIBL Coefficient     —     0.1       DELTA2     DIBL Coefficient 2     —     0       DIBSAT     DIBL saturation Voltage     V     10       EPSILON     Mobility dependence on temperature     —     2.3  | DELTA1FP4 | FP DIBL Coefficient                          | _     | 0       |
| DELTA2     DIBL Coefficient 2     —     0       DIBSAT     DIBL saturation Voltage     V     10       EPSILON     Mobility dependence on temperature     —     2.3  | DELTA1RD  | DAR DIBL Coefficient                         | _     | 0.35    |
| DIBSAT DIBL saturation Voltage V 10 EPSILON Mobility dependence on temperature — 2.3  | DELTA1RS  | SAR DIBL Coefficient                         | _     | 0.1     |
| EPSILON Mobility dependence on temperature — 2.3  | DELTA2    | DIBL Coefficient 2                           | _     | 0       |
|   | DIBSAT    | DIBL saturation Voltage                      | V     | 10      |
| FFE Flicker noise exponent for frequency — 1.2  | EPSILON   | Mobility dependence on temperature           | _     | 2.3     |
|   | FFE       | Flicker noise exponent for frequency         | _     | 1.2     |

Table 2-136. MVSG-HV HEMT MODEL Device Model Parameters

| Parameter | Description   | Units | Default  |
|-----------|---|-------|----------|
| FLAGFP1   | Flag parameter: GFP=1 or SFP=0  | _     | 1        |
| FLAGFP1S  | Flag parameter: cfp1s select=1 or cfp1s not select=0  | _     | 1        |
| FLAGFP2   | Flag parameter: GFP=1 or SFP=0  | _     | 0        |
| FLAGFP2S  | Flag parameter: cfp1s select=1 or cfp1s not select=0  | _     | 1        |
| FLAGFP3   | Flag parameter: GFP=1 or SFP=0  | _     | 0        |
| FLAGFP3S  | Flag parameter: cfp1s select=1 or cfp1s not select=0  | _     | 1        |
| FLAGFP4   | Flag parameter: GFP=1 or SFP=0  | _     | 0        |
| FLAGFP4S  | Flag parameter: cfp1s select=1 or cfp1s not select=0  | _     | 1        |
| FLAGRES   | Flag parameter for resistor: resistor is chosen if flagres=1 or implicit transitor is chosen if flagres=0 | _     | 0        |
| FRACD     | G-D fractional change in ideality factor due to high injection  | _     | 0.5      |
| FRACS     | G-S fractional change in ideality factor due to high injection  | _     | 0.5      |
| GMDISP    | Flag parameter for gm-dispersion 0=off, 1=on  | _     | 0        |
| IGMOD     | Flag parameter for gate leakage 0=off, 1=on   | _     | 1        |
| IJD       | G-D reverse leakage current normalized to width   | _     | 1e-12    |
| IJS       | G-S reverse leakage current normalized to width   | _     | 1e-12    |
| IRECD     | G-D reverse leakage current normalized to width   | _     | 2e-05    |
| IRECS     | G-S reverse leakage current normalized to width   | _     | 1e-18    |
| KBDGATED  | G-D fitting parameter to turn on the breakdown of G-D diode   | _     | 0        |
| KBDGATES  | G-S fitting parameter to turn on the breakdown of G-S diode   | _     | 0        |
| KF        | Flicker noise coefficient   | _     | 0.0001   |
| LAMBDA    | CLM parameter   | _     | 0        |
| LGD       | Drain access region (DAR) length parameter  | m     | 4.85e-06 |
| LGFP1     | FP Length   | m     | 0        |
| LGFP2     | FP Length   | m     | 0        |
| LGFP3     | FP Length   | m     | 0        |
| LGFP4     | FP Length   | m     | 0        |
| LGS       | Source access region (SAR) length parameter   | m     | 3e-06    |
| LMAX      | Maximum length for use of this model  | m     | 100      |
| LMIN      | Minimum length for use of this model  | m     | 0        |
| MINC      | Minimum capacitance   | F     | 0        |
| MINL      | Minimum length of access or FP regions for modeling them as transistors                                   | m     | 1e-09    |
| MINR      | Minimum resistance  | Ω     | 0.001    |

Table 2-136. MVSG-HV HEMT MODEL Device Model Parameters

| Parameter | Description  | Units    | Default |
|-----------|--|----------|---------|
| MTHETA    | Scattering: mobility reduction parameter with Vg             | _        | 0       |
| MTHETAFP1 | FP scattering: mobility reduction parameter with Vg          | _        | 0       |
| MTHETAFP2 | FP scattering: mobility reduction parameter with Vg          | _        | 0       |
| MTHETAFP3 | FP scattering: mobility reduction parameter with Vg          | _        | 0       |
| MTHETAFP4 | FP scattering: mobility reduction parameter with Vg          | _        | 0       |
| MTHETARD  | DAR scattering: mobility reduction parameter with Vg         | _        | 0       |
| MTHETARS  | SAR scattering: mobility reduction parameter with Vg         | _        | 0       |
| MU0       | Low-field mobility   | _        | 0.135   |
| MU0FP1    | FP low-field mobility  | _        | 0.2     |
| MU0FP2    | FP low-field mobility  | _        | 0.2     |
| MU0FP3    | FP low-field mobility  | _        | 0.2     |
| MU0FP4    | FP low-field mobility  | _        | 0.2     |
| MU0RD     | DAR low-field mobility                                       | _        | 0.1     |
| MU0RS     | SAR low-field mobility                                       | _        | 0.1     |
| ND        | Punchthrough factor for subth slope                          | _        | 0       |
| NDFP1     | FP punchthrough factor for subth slope                       | _        | 0       |
| NDFP2     | FP punchthrough factor for subth slope                       | _        | 0       |
| NDFP3     | FP punchthrough factor for subth slope                       | _        | 0       |
| NDFP4     | FP punchthrough factor for subth slope                       |          | 0       |
| NDRD      | DAR punchthrough factor for subth slope                      |          | 3.8     |
| NDRS      | SAR punchthrough factor for subth slope                      |          | 0       |
| NOISEMOD  | Select knob for noise model 0=off, 1=on                      | _        | 0       |
| PBDGD     | G-D fitting parameter for breakdown: Something like 1/eta*Vt | _        | 4       |
| PBDGS     | G-S fitting parameter for breakdown: Something like 1/eta*Vt |          | 4       |
| PG_PARAM1 | Something like 1/eta   | _        | 0.82    |
| PG_PARAMD | G-D something like 1/eta*Vt                                  | <u> </u> | 1       |
| PG_PARAMS | G-S something like 1/eta*Vt                                  |          | 1       |
| PGSRECD   | G-D something like 1/eta for reverse recombination           |          | 0.8     |
| PGSRECS   | G-S something like 1/eta for reverse recombination           |          | 0.5     |
| RCD       | Drain contact resistance * Width                             | _        | 0.0008  |
| RCS       | Source contact resistance * Width                            | _        | 0.0008  |
| RCT1      | Linear Rsh and Rc temperature coefficient                    | 1/K      | 0       |
|           |  |          |         |
| RCT2      | Quadratic Rsh and Rc temperature coefficient                 | _        | 0       |

Table 2-136. MVSG-HV HEMT MODEL Device Model Parameters

| ### ### ##############################   | Parameter  | Description  | Units | Default |
|--|------------|--|-------|---------|
| FP Sub-threshold slope   | RSH        | 2-DEG Sheet Resistance                               |       | 150     |
| SFP2   | RTH        | Thermal resistance                                   |       | 25      |
| PP Sub-threshold slope   | SFP1       | FP Sub-threshold slope                               | _     | 3.2     |
| SEPP 4   | SFP2       | FP Sub-threshold slope                               | _     | 3.2     |
| G-D shot noise parameter — 3 SHS G-S shot noise parameter — 3 SHS G-S shot noise parameter — 0.3 SRS SAR Sub-threshold slope — 0.1 SSS SAR Sub-threshold slope — 0.12 TAUGMRF gm-dispersion time constant s 0.001 TAUT Trap time constant s 0.001 TAUT Trap time constant s 3e-05 TEMPT Temperature coefficient for trapping I/K 0.0001 TROM Reference temperature for the model — 27 TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 VVDGGD G-D soft breakdown voltage of G-D diode V 600 VVERSION Version number — 1 VVGSATO G-D high injection effect V 1 VVGSATO G-D mimics depletion saturation V 0.8 VVGSATQS G-S mimics depletion saturation V 0.8 VVGSATQS G-S high injection effect V 1 VVTHETAFP Scattering: velocity reduction parameter with Vg — 0 VVTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VVTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP DAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTHETARP SAR scattering: velocity reduction parameter with Vg — 0 VVTO Threshold voltage V - 2.72 VVTOFP1 FP threshold voltage V - 74.5  | SFP3       | FP Sub-threshold slope                               | _     | 3.2     |
| G-S shot noise parameter — 3 SRD DAR Sub-threshold slope — 0.3 SRS SAR Sub-threshold slope — 0.12 SRS SUb-threshold slope — 0.12 TAUGMRF gm-dispersion time constant s 0.001 TAUT Trap time constant s 0.001 TAUT Trap time constant s 3-e.05 TEMPT Temperature coefficient for trapping 1/K 0.0001 TNOM Reference temperature for the model — 27 TTAPASELECT Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 VEDGD G-D soft breakdown voltage of G-D diode V 600 VERSION Version number — 1 VGSATD G-D high injection effect V 1 VGSATQB G-S mimics depletion saturation V 0.8 VGSATQS G-S mimics depletion saturation V 0.8 VGSATQS G-S high injection effect V 1 VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP5 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP6 DAR scattering: velocity reduction parameter with Vg — 0 VTHETAFP7 DAR scattering: velocity reduction parameter with Vg — 0 VTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VTO Threshold voltage V - 2.72 VTOFP1 FP threshold voltage V - 74.5  | SFP4       | FP Sub-threshold slope                               | _     | 3.2     |
| DAR Sub-threshold slope — 0.3  SRS SAR Sub-threshold slope — 0.1  SRS Sub-threshold slope — 0.12  TAUGMRF gm-dispersion time constant s 0.001  TAUT Trap time constant s 3e-05  TEMPT Temperature coefficient for trapping 1/K 0.0001  TNOM Reference temperature for the model — 27  TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0  TYPE nFET=1 pFET=-1 — 1  VADGD G-D soft breakdown voltage of G-D diode V 600  VERSION Version number — 1  VGSATQD G-D high injection effect V 1  VGSATQD G-D mimics depletion saturation V 0.8  VGSATQS G-S mimics depletion saturation V 1.1  VGSATQS G-S high injection effect V 1.1  VGSATQS G-S high injection effect V 1.1  VTHETA Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5   | SHD        | G-D shot noise parameter                             | _     | 3       |
| SAR Sub-threshold slope — 0.1  SS Sub-threshold slope — 0.12  TAUGMRF gm-dispersion time constant s 0.001  TAUT Trap time constant s 3e-05  TEMPT Temperature coefficient for trapping 1/K 0.0001  TNOM Reference temperature for the model — 27  TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0  TYPE nFET=1 pFET=-1 — 1  VBDGD G-D soft breakdown voltage of G-D diode V 600  VBDGS G-S soft breakdown voltage of G-S diode V 600  VERSION Version number — 1  VGSATQD G-D high injection effect V 1  VGSATQS G-S mimics depletion saturation V 0.8  VGSATQS G-S high injection effect V 1  VGSATQS G-S high injection effect V 1.1  VGSATQS G-S high injection effect V 1.1  VGSATS G-S high injection effect V 1.1  VTHETA Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.772  VTOPP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -44.5   | SHS        | G-S shot noise parameter                             | _     | 3       |
| Sub-threshold slope — 0.12 TAUGMRF gm-dispersion time constant s 0.001 TAUT Trap time constant s 3e-05 TEMPT Temperature coefficient for trapping 1/K 0.0001 TNOM Reference temperature for the model — 27 TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 VBDGD G-D soft breakdown voltage of G-D diode V 600 VBDGS G-S soft breakdown voltage of G-S diode V 600 VBDGS G-S soft breakdown voltage of G-S diode V 600 VBCSATON Version number — 1 VGSATO G-D high injection effect V 1 VGSATQD G-D mimics depletion saturation V 0.8 VGSATQS G-S mimics depletion saturation V 2 VGSATQS G-S high injection effect V 1 VGSATQS G-S high injection effect V 1 VGSATQS G-S diode cut in voltage V 1.1 VGSATQS G-S diode cut in voltage V 1.1 VGTHETA Scattering: velocity reduction parameter with Vg — 0 VGTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VGTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VGTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 VGTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VGTHETARD DAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VGTHETARS SAR scattering: ve | SRD        | DAR Sub-threshold slope                              | _     | 0.3     |
| TAUGMRF gm-dispersion time constant s 0.001 TAUT Trap time constant s 3e-05 TEMPT Temperature coefficient for trapping 1/K 0.0001 TROM Reference temperature for the model — 27 TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 VVBDGD G-D soft breakdown voltage of G-D diode V 600 VVBDGS G-S soft breakdown voltage of G-S diode V 600 VVBDGS G-S soft breakdown voltage of G-S diode V 600 VVBSION Version number — 1 VVGSATD G-D high injection effect V 1 VVGSATQD G-D mimics depletion saturation V 0.8 VVGSATQS G-S mimics depletion saturation V 2 VVGSATQS G-S high injection effect V 1 VVGSATQS G-S diode V 1.1 VVHETA Scattering: velocity reduction parameter with Vg — 0 VVHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP5 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP6 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP7 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 SAR scattering: velocity reduction parameter with Vg — 0 VVHETARS SAR scattering: velocity reduction parameter with Vg — 0 VVHETARS SAR scattering: velocity reduction parameter with Vg — 0 VVHO Threshold voltage V -2.72 VVTOFP1 FP threshold voltage V -74.5  | SRS        | SAR Sub-threshold slope                              | _     | 0.1     |
| TRAUT Trap time constant s 3e-05 TEMPT Temperature coefficient for trapping 1/K 0.0001 TNOM Reference temperature for the model — 27 TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 WEDGD G-D soft breakdown voltage of G-D diode V 600 WEDGS G-S soft breakdown voltage of G-S diode V 600 WERSION Version number — 1 WGSATD G-D high injection effect V 1 WGSATQD G-D mimics depletion saturation V 2 WGSATQS G-S mimics depletion saturation V 2 WGSATQS G-S high injection effect V 1 WJG Gate diode cut in voltage V 1.1 WTHETAF Scattering: velocity reduction parameter with Vg — 0 WTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP5 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP6 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP7 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP9 FP scattering: velocity reduction parameter | SS         | Sub-threshold slope                                  | _     | 0.12    |
| TEMPT Temperature coefficient for trapping 1/K 0.0001 TNOM Reference temperature for the model — 27 TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 VVBDGD G-D soft breakdown voltage of G-D diode V 600 VVBDGS G-S soft breakdown voltage of G-S diode V 600 VVBSION Version number — 1 VVGSATD G-D high injection effect V 1 VVGSATQD G-D mimics depletion saturation V 2 VVGSATQS G-S mimics depletion saturation V 2 VVGSATS G-S high injection effect V 1 VVHETA Scattering: velocity reduction parameter with Vg — 0 VVHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP5 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP6 DAR scattering: velocity reduction parameter with Vg — 0 VVHETAFP7 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 VVHETAFP9 FP scattering: velocity reduction parameter with Vg — 0 VVHETARD DAR scattering: velocity reduction parameter with Vg — 0 VVHETARS SAR scattering: velocity reduction parameter with Vg — 0 VVTO Threshold voltage V -2.72 VVTOFP1 FP threshold voltage V -44.5 VVTOFP2 FP threshold voltage V -74.5  | TAUGMRF    | gm-dispersion time constant                          | S     | 0.001   |
| Reference temperature for the model — 27  TRAPSELECT Select knob for charge trapping 0=off, 1=on — 0  TYPE nFET=1 pFET=-1 — 1  VBDGD G-D soft breakdown voltage of G-D diode V 600  VBDGS G-S soft breakdown voltage of G-S diode V 600  VERSION Version number — 1  VGSATD G-D high injection effect V 1  VGSATQD G-D mimics depletion saturation V 2  VGSATQS G-S mimics depletion saturation V 2  VGSATS G-S high injection effect V 1  VJG Gate diode cut in voltage V 1.1  VTHETA Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5  | TAUT       | Trap time constant                                   | s     | 3e-05   |
| Select knob for charge trapping 0=off, 1=on — 0 TYPE nFET=1 pFET=-1 — 1 WBDGD G-D soft breakdown voltage of G-D diode V 600 WBDGS G-S soft breakdown voltage of G-S diode V 600 WERSION Version number — 1 WGSATD G-D high injection effect V 1 WGSATQD G-D mimics depletion saturation V 0.8 WGSATQS G-S mimics depletion saturation V 2 WGSATS G-S high injection effect V 1 WJG Gate diode cut in voltage V 1.1 WTHETA Scattering: velocity reduction parameter with Vg — 0 WTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP5 FP scattering: velocity reduction parameter with Vg — 0 WTHETAFP6 DAR scattering: velocity reduction parameter with Vg — 0 WTHETARD DAR scattering: velocity reduction parameter with Vg — 0 WTHETARS SAR scattering: velocity reduction parameter with Vg — 0 WTHETARS SAR scattering: velocity reduction parameter with Vg — 0 WTO Threshold voltage V -2.72 WTOFP1 FP threshold voltage V -74.5  | TEMPT      | Temperature coefficient for trapping                 | 1/K   | 0.0001  |
| TYPE nFET=1 pFET=-1 — 1  WBDGD G-D soft breakdown voltage of G-D diode V 600  WBDGS G-S soft breakdown voltage of G-S diode V 600  WERSION Version number — 1  WGSATD G-D high injection effect V 1  WGSATQD G-D mimics depletion saturation V 0.8  WGSATQS G-S mimics depletion saturation V 2  WGSATS G-S high injection effect V 1  WJG Gate diode cut in voltage V 1.1  WTHETA Scattering: velocity reduction parameter with Vg — 0  WTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0  WTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0  WTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0  WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  WTHETAFP5 DAR scattering: velocity reduction parameter with Vg — 0  WTHETARD DAR scattering: velocity reduction parameter with Vg — 0  WTHETARS SAR scattering: velocity reduction parameter with Vg — 0  WTO Threshold voltage V -2.72  WTOFP1 FP threshold voltage V -44.5  WTOFP2 FP threshold voltage V -74.5  | TNOM       | Reference temperature for the model                  | _     | 27      |
| G-D soft breakdown voltage of G-D diode VBDGS G-S soft breakdown voltage of G-D diode VBDGS G-S soft breakdown voltage of G-S diode VBDGS G-S soft breakdown voltage of G-S diode VBDGS VBDGS G-S soft breakdown voltage of G-S diode VBDGS VBDGS VBDGS VBDGS G-D high injection effect V 1 VDGSATQD G-D mimics depletion saturation V 2 VBSATQS G-S mimics depletion saturation V 2 VBSATQS G-S high injection effect V 1 VDG Gate diode cut in voltage V 1.1 VDTHETA Scattering: velocity reduction parameter with Vg VDTHETAFP1 FP scattering: velocity reduction parameter with Vg VDTHETAFP2 FP scattering: velocity reduction parameter with Vg VDTHETAFP3 FP scattering: velocity reduction parameter with Vg VDTHETAFP4 FP scattering: velocity reduction parameter with Vg VDTHETARD DAR scattering: velocity reduction parameter with Vg VDTHETARD DAR scattering: velocity reduction parameter with Vg VDTHETARS SAR scattering: velocity reduction parameter with Vg VDTO Threshold voltage V -2.72 VDTOFP1 FP threshold voltage V -74.5   | TRAPSELECT | Select knob for charge trapping 0=off, 1=on          | _     | 0       |
| WERSION Version number ————————————————————————————————————  | TYPE       | nFET=1 pFET=-1                                       | _     | 1       |
| Version number — 1 VGSATD G-D high injection effect V 1 VGSATQD G-D mimics depletion saturation V 0.8 VGSATQS G-S mimics depletion saturation V 2 VGSATS G-S high injection effect V 1 VJG Gate diode cut in voltage V 1.1 VTHETA Scattering: velocity reduction parameter with Vg — 0 VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP5 SAR scattering: velocity reduction parameter with Vg — 0 VTHETARD DAR scattering: velocity reduction parameter with Vg — 0 VTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VTO Threshold voltage V -2.72 VTOFP1 FP threshold voltage V -44.5 VTOFP2 FP threshold voltage V -74.5  | VBDGD      | G-D soft breakdown voltage of G-D diode              | V     | 600     |
| G-D high injection effect V 1 VGSATQD G-D mimics depletion saturation V 0.8 VGSATQS G-S mimics depletion saturation V 2 VGSATS G-S high injection effect V 1 VJG Gate diode cut in voltage V 1.1 VTHETA Scattering: velocity reduction parameter with Vg — 0 VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP5 FP scattering: velocity reduction parameter with Vg — 0 VTHETAFP6 DAR scattering: velocity reduction parameter with Vg — 0 VTHETARD DAR scattering: velocity reduction parameter with Vg — 0 VTHETARS SAR scattering: velocity reduction parameter with Vg — 0 VTO Threshold voltage V -2.72 VTOFP1 FP threshold voltage V -74.5  | VBDGS      | G-S soft breakdown voltage of G-S diode              | V     | 600     |
| G-D mimics depletion saturation  V 0.8  VGSATQS  G-S mimics depletion saturation  V 2  VGSATS  G-S high injection effect  V 1  VJG  Gate diode cut in voltage  V 1.1  VTHETA  Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4  FP scattering: velocity reduction parameter with Vg — 0  VTHETARD  DAR scattering: velocity reduction parameter with Vg — 0  VTHETARD  DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS  SAR scattering: velocity reduction parameter with Vg — 0  VTO  Threshold voltage  V -2.72  VTOFP1  FP threshold voltage  V -74.5   | VERSION    | Version number                                       | _     | 1       |
| G-S mimics depletion saturation  V 2 VGSATS  G-S high injection effect  V 1 VJG  Gate diode cut in voltage  V 1.1  VTHETA  Scattering: velocity reduction parameter with Vg  VTHETAFP1  FP scattering: velocity reduction parameter with Vg  VTHETAFP2  FP scattering: velocity reduction parameter with Vg  VTHETAFP3  FP scattering: velocity reduction parameter with Vg  VTHETAFP4  FP scattering: velocity reduction parameter with Vg  VTHETARD  DAR scattering: velocity reduction parameter with Vg  VTHETARD  DAR scattering: velocity reduction parameter with Vg  VTHETARD  Threshold voltage  V 2 VTOFP1  FP threshold voltage  V -74.5  VTOFP2  FP threshold voltage  V -74.5   | VGSATD     | G-D high injection effect                            | V     | 1       |
| G-S high injection effect  V 1  VJG Gate diode cut in voltage  V 1.1  VTHETA  Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4  FP scattering: velocity reduction parameter with Vg — 0  VTHETARD  DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS  SAR scattering: velocity reduction parameter with Vg — 0  VTO  Threshold voltage  V -2.72  VTOFP1  FP threshold voltage  V -74.5   | VGSATQD    | G-D mimics depletion saturation                      | V     | 0.8     |
| Gate diode cut in voltage  V 1.1  VTHETA  Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4  FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4  FP scattering: velocity reduction parameter with Vg — 0  VTHETARD  DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS  SAR scattering: velocity reduction parameter with Vg — 0  VTO  Threshold voltage  V -2.72  VTOFP1  FP threshold voltage  V -74.5   | VGSATQS    | G-S mimics depletion saturation                      | V     | 2       |
| Scattering: velocity reduction parameter with Vg — 0  VTHETAFP1 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5  | VGSATS     | G-S high injection effect                            | V     | 1       |
| FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP2 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5  | VJG        | Gate diode cut in voltage                            | V     | 1.1     |
| FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP3 FP scattering: velocity reduction parameter with Vg — 0  VTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5   | VTHETA     | Scattering: velocity reduction parameter with Vg     |       | 0       |
| FP scattering: velocity reduction parameter with Vg — 0  WTHETAFP4 FP scattering: velocity reduction parameter with Vg — 0  WTHETARD DAR scattering: velocity reduction parameter with Vg — 0  WTHETARS SAR scattering: velocity reduction parameter with Vg — 0  WTO Threshold voltage V -2.72  WTOFP1 FP threshold voltage V -44.5  WTOFP2 FP threshold voltage V -74.5  | VTHETAFP1  | FP scattering: velocity reduction parameter with Vg  |       | 0       |
| FP scattering: velocity reduction parameter with Vg — 0  VTHETARD DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5   | VTHETAFP2  | FP scattering: velocity reduction parameter with Vg  |       | 0       |
| DAR scattering: velocity reduction parameter with Vg — 0  VTHETARS SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5   | VTHETAFP3  | FP scattering: velocity reduction parameter with Vg  |       | 0       |
| SAR scattering: velocity reduction parameter with Vg — 0  VTO Threshold voltage V -2.72  VTOFP1 FP threshold voltage V -44.5  VTOFP2 FP threshold voltage V -74.5  | VTHETAFP4  | FP scattering: velocity reduction parameter with Vg  |       | 0       |
| VTO Threshold voltage V -2.72 VTOFP1 FP threshold voltage V -44.5 VTOFP2 FP threshold voltage V -74.5  | VTHETARD   | DAR scattering: velocity reduction parameter with Vg |       | 0       |
| VTOFP1 FP threshold voltage V -44.5 VTOFP2 FP threshold voltage V -74.5  | VTHETARS   | SAR scattering: velocity reduction parameter with Vg |       | 0       |
| VTOFP2 FP threshold voltage V -74.5  | VTO        | Threshold voltage                                    | V     | -2.72   |
|  | VTOFP1     | FP threshold voltage                                 | V     | -44.5   |
| VTOFP3 FP threshold voltage V -44.5  | VTOFP2     | FP threshold voltage                                 | V     | -74.5   |
|  | VTOFP3     | FP threshold voltage                                 | V     | -44.5   |

Table 2-136. MVSG-HV HEMT MODEL Device Model Parameters

| Parameter | Description                         | Units | Default |
|-----------|-------------------------------------|-------|---------|
| VTOFP4    | FP threshold voltage                | V     | -44.5   |
| VTORD     | DAR threshold voltage               | V     | -650    |
| VTORS     | SAR threshold voltage               | V     | -650    |
| VTTRAP    | Trapping stress threshold voltage   | V     | 230     |
| VTZETA    | vto dependence on temperature       | V/K   | -0.0004 |
| VX0       | Source injection velocity           | _     | 300000  |
| VX0FP1    | FP source injection velocity        | _     | 120000  |
| VX0FP2    | FP source injection velocity        | _     | 120000  |
| VX0FP3    | FP source injection velocity        | _     | 120000  |
| VX0FP4    | FP source injection velocity        | _     | 120000  |
| VX0RD     | DAR source injection velocity       | _     | 100000  |
| VXORS     | SAR source injection velocity       | _     | 100000  |
| VZETA     | vx0 dependence on temperature       | 1/K   | 150000  |
| WMAX      | Maximum width for use of this model | m     | 100     |
| WMIN      | Minimum width for use of this model | m     | 0       |

Table 2-137. MOSFET level 2002 Output Variables

| vgisi       internal gate-source voltage       V       none         vdisi       internal drain-source voltage       V       none         vti       internal threshold voltage including DIBL       V       none         vdsati       internal drain-source saturation voltage       V       none         pdc       total power dissipation from the device       W       none         idisi       drain-to-source current in intrinsic transistor       A       none         igs       gate-source gate-leakage current       A       none         igd       gate-drain gate-leakage current       A       none         qgi       intrinsic gate charge       C       none         qdi       intrinsic drain charge       C       none         qsi       intrinsic source charge       C       none         qbi       intrinsic body charge       C       none         gmi       intrinsic transconductance       A/V       none         gdsi       intrinsic body-transconductance       A/V       none         gmbsi       intrinsic body-transconductance       A/V       none | Parameter | Description                                     | Units | Default |
|---|-----------|---|-------|---------|
| vti       internal threshold voltage including DIBL       V       none         vdsati       internal drain-source saturation voltage       V       none         pdc       total power dissipation from the device       W       none         idisi       drain-to-source current in intrinsic transistor       A       none         igs       gate-source gate-leakage current       A       none         igd       gate-drain gate-leakage current       A       none         qgi       intrinsic gate charge       C       none         qdi       intrinsic drain charge       C       none         qsi       intrinsic source charge       C       none         qbi       intrinsic body charge       C       none         gmi       intrinsic transconductance       A/V       none         gdsi       intrinsic output-conductance       A/V       none  | vgisi     | internal gate-source voltage                    | V     | none    |
| vdsatiinternal drain-source saturation voltageVnonepdctotal power dissipation from the deviceWnoneidisidrain-to-source current in intrinsic transistorAnoneigsgate-source gate-leakage currentAnoneigdgate-drain gate-leakage currentAnoneqgiintrinsic gate chargeCnoneqdiintrinsic drain chargeCnoneqsiintrinsic source chargeCnoneqbiintrinsic body chargeCnonegmiintrinsic transconductanceA/Vnonegdsiintrinsic output-conductanceA/Vnone  | vdisi     | internal drain-source voltage                   | V     | none    |
| pdctotal power dissipation from the deviceWnoneidisidrain-to-source current in intrinsic transistorAnoneigsgate-source gate-leakage currentAnoneigdgate-drain gate-leakage currentAnoneqgiintrinsic gate chargeCnoneqdiintrinsic drain chargeCnoneqsiintrinsic source chargeCnoneqbiintrinsic body chargeCnonegmiintrinsic transconductanceA/Vnonegdsiintrinsic output-conductanceA/Vnone   | vti       | internal threshold voltage including DIBL       | V     | none    |
| idisi       drain-to-source current in intrinsic transistor       A       none         igs       gate-source gate-leakage current       A       none         igd       gate-drain gate-leakage current       A       none         qgi       intrinsic gate charge       C       none         qdi       intrinsic drain charge       C       none         qsi       intrinsic source charge       C       none         qbi       intrinsic body charge       C       none         gmi       intrinsic transconductance       A/V       none         gdsi       intrinsic output-conductance       A/V       none   | vdsati    | internal drain-source saturation voltage        | V     | none    |
| igsgate-source gate-leakage currentAnoneigdgate-drain gate-leakage currentAnoneqgiintrinsic gate chargeCnoneqdiintrinsic drain chargeCnoneqsiintrinsic source chargeCnoneqbiintrinsic body chargeCnonegmiintrinsic transconductanceA/Vnonegdsiintrinsic output-conductanceA/Vnone   | pdc       | total power dissipation from the device         | W     | none    |
| igd       gate-drain gate-leakage current       A       none         qgi       intrinsic gate charge       C       none         qdi       intrinsic drain charge       C       none         qsi       intrinsic source charge       C       none         qbi       intrinsic body charge       C       none         gmi       intrinsic transconductance       A/V       none         gdsi       intrinsic output-conductance       A/V       none  | idisi     | drain-to-source current in intrinsic transistor | A     | none    |
| qgiintrinsic gate chargeCnoneqdiintrinsic drain chargeCnoneqsiintrinsic source chargeCnoneqbiintrinsic body chargeCnonegmiintrinsic transconductanceA/Vnonegdsiintrinsic output-conductanceA/Vnone  | igs       | gate-source gate-leakage current                | A     | none    |
| qdi     intrinsic drain charge     C     none       qsi     intrinsic source charge     C     none       qbi     intrinsic body charge     C     none       gmi     intrinsic transconductance     A/V     none       gdsi     intrinsic output-conductance     A/V     none  | igd       | gate-drain gate-leakage current                 | A     | none    |
| qsi     intrinsic source charge     C     none       qbi     intrinsic body charge     C     none       gmi     intrinsic transconductance     A/V     none       gdsi     intrinsic output-conductance     A/V     none  | qgi       | intrinsic gate charge                           | C     | none    |
| qbi intrinsic body charge C none gmi intrinsic transconductance A/V none gdsi intrinsic output-conductance A/V none   | qdi       | intrinsic drain charge                          | C     | none    |
| gmi intrinsic transconductance A/V none gdsi intrinsic output-conductance A/V none  | qsi       | intrinsic source charge                         | C     | none    |
| gdsi intrinsic output-conductance A/V none  | qbi       | intrinsic body charge                           | C     | none    |
| *   | gmi       | intrinsic transconductance                      | A/V   | none    |
| gmbsi intrinsic body-transconductance A/V none  | gdsi      | intrinsic output-conductance                    | A/V   | none    |
|   | gmbsi     | intrinsic body-transconductance                 | A/V   | none    |
| cggi intrinsic gate-gate capacitance F none   | cggi      | intrinsic gate-gate capacitance                 | F     | none    |
| cgdi intrinsic gate-drain capacitance F none  | cgdi      | intrinsic gate-drain capacitance                | F     | none    |

Table 2-137. MOSFET level 2002 Output Variables

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| cgsi       | intrinsic gate-source capacitance                   | F     | none    |
| cgbi       | intrinsic gate-body capacitance                     | F     | none    |
| cdgi       | intrinsic drain-gate capacitance                    | F     | none    |
| cddi       | intrinsic drain-drain capacitance                   | F     | none    |
| cdsi       | intrinsic drain-source capacitance                  | F     | none    |
| cdbi       | intrinsic drain-body capacitance                    | F     | none    |
| csgi       | intrinsic source-gate capacitance                   | F     | none    |
| csdi       | intrinsic source-drain capacitance                  | F     | none    |
| cssi       | intrinsic source-source capacitance                 | F     | none    |
| csbi       | intrinsic source-body capacitance                   | F     | none    |
| cbgi       | intrinsic body-gate capacitance                     | F     | none    |
| cbdi       | intrinsic body-drain capacitance                    | F     | none    |
| cbsi       | intrinsic body-source capacitance                   | F     | none    |
| cbbi       | intrinsic body-body capacitance                     | F     | none    |
| cgs        | gate-to-source fringing capacitance                 | F     | none    |
| cgd        | gate-to-drain fringing capacitance                  | F     | none    |
| t_total_k  | actual device temperature in Kelvin                 | K     | none    |
| t_total_c  | actual device temperature in Celsius                | deg C | none    |
| t_delta_sh | change in device temperature caused by self-heating | K     | none    |
| rs         | resistance of source access region                  | Ohm   | none    |
| rd         | resistance of drain access region                   | Ohm   | none    |

## 2.3.20.17. Level 301 MOSFET Tables (EKV version 3.0.1)

Xyce includes the EKV MOSFET model, version 3.0.1 [20][32][33]. Full documentation for the EKV3 model is available on the Xyce internal web site; the documentation for the EKV3 model may be freely redistributed. Instance and model parameters for the EKV model are given in tables 2-138 and 2-139.

The EKV3 model is developed by the EKV Team of the Electronics Laboratory-TUC (Technical University of Crete). It is included in Xyce under license from Technical University of Crete. The official web site of the EKV model is http://ekv.epfl.ch/.

Due to licensing restrictions, the EKV3 MOSFET is not available in open-source versions of Xyce. The license for EKV3 authorizes Sandia National Laboratories to distribute EKV3 only in binary versions of code.

Table 2-138. EKV3 MOSFET Device Instance Parameters

| Parameter | Description                           | Units | Default |
|-----------|---------------------------------------|-------|---------|
| AD        | DRAIN'S AREA                          | _     | 0       |
| AS        | SOURCE'S AREA                         | _     | 0       |
| L         | GATE'S LENGTH                         | _     | 1e-05   |
| M         | NUMBER OF DEVICES IN PARALLEL         | _     | 1       |
| NF        | NUMBER OF FINGERS                     | _     | 1       |
| PD        | DRAIN'S PERIMETER                     | _     | 0       |
| PS        | SOURCE'S PERIMETER                    | _     | 0       |
| SA        | STI PARAMETER; DISTANCE FROM STI      | _     | 0       |
| SB        | STI PARAMETER; DISTANCE FROM STI      | _     | 0       |
| SD        | STI PARAMETER; DISTANCE BETWEEN GATES | _     | 0       |
| W         | GATE'S WIDTH                          | _     | 1e-05   |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter | Description                                | Units | Default |
|-----------|--|-------|---------|
| ACLM      |  | -     | 0.83    |
| AF        |  | _     | 1       |
| AGAM      |  | _     | 0       |
| AGAMMA    | MATCHING PARAMETER FOR BODY FACTOR (GAMMA) | _     | 0       |
| AGIDL     |  | _     | 0       |
| AKP       | MATCHING PARAMETER FOR MOBILITY (KP)       | _     | 0       |
| AQMA      |  | _     | 0.5     |
| AQMI      |  | _     | 0.4     |
| AVT       |  | _     | 0       |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter  | Description                                    | Units | Default |
|------------|--|-------|---------|
| AVTO       | MATCHING PARAMETER FOR THRESHOLD VOLTAGE (VTO) | -     | 0       |
| BEX        |  | _     | -1.5    |
| BGIDL      |  | _     | 2.3e+09 |
| BVD        |  | _     | 10      |
| BVS        |  | _     | 10      |
| CGBO       |  | _     | 0       |
| CGDO       |  | _     | 0       |
| CGIDL      |  | _     | 0.5     |
| CGSO       |  | _     | 0       |
| CJD        |  | _     | 0       |
| CJF        |  | _     | 0       |
| CJS        |  | _     | 0       |
| CJSWD      |  | _     | 0       |
| CJSWGD     |  | _     | 0       |
| CJSWGS     |  | _     | 0       |
| CJSWS      |  | _     | 0       |
| COX        |  | _     | 0.012   |
| DDITS      |  | _     | 0.3     |
| DELTA      |  | _     | 2       |
| OFR        |  | _     | 0.001   |
| DGAMMAEDGE |  | _     | 0       |
| DL         |  | _     | -1e-08  |
| DLC        |  | _     | 0       |
| DPHIEDGE   |  | _     | 0       |
| DW         |  | _     | -1e-08  |
| DWC        |  | _     | 0       |
| E0         |  | _     | 1e+10   |
| E1         |  | _     | 3.1e+08 |
| EB         |  | _     | 2.9e+10 |
| EF         |  | _     | 2       |
| EGIDL      |  | _     | 0.8     |
| ETA        |  | _     | 0.5     |
| ETAD       |  | _     | 1       |
| ETAQM      |  | _     | 0.75    |
| FLR        |  | _     | 0       |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter  | Description | Units | Default |
|------------|-------------|-------|---------|
| FPROUT     |             | -     | 1e+06   |
| GAMMA      |             | _     | 0.3     |
| GAMMAG     |             | _     | 4.1     |
| GAMMAGOV   |             | _     | 10      |
| GAMMAOV    |             | _     | 1.6     |
| GC         |             | _     | 1       |
| GMIN       |             | _     | 0       |
| HDIF       |             | _     | 0       |
| IBA        |             | _     | 0       |
| IBB        |             | _     | 3e+08   |
| IBBT       |             | _     | 0.0008  |
| IBN        |             | _     | 1       |
| INFO_LEVEL |             | _     | 0       |
| JSD        |             | -     | 0       |
| JSS        |             | _     | 0       |
| JSSWD      |             | _     | 0       |
| JSSWGD     |             | _     | 0       |
| JSSWGS     |             | _     | 0       |
| JSSWS      |             | _     | 0       |
| JTSD       |             | _     | 0       |
| JTSS       |             | _     | 0       |
| JTSSWD     |             | _     | 0       |
| JTSSWGD    |             | _     | 0       |
| JTSSWGS    |             | -     | 0       |
| JTSSWS     |             | _     | 0       |
| KA         |             | _     | 0       |
| KB         |             | _     | 0       |
| KETAD      |             | _     | 0       |
| KF         |             | _     | 0       |
| KG         |             | _     | 0       |
| KGAMMA     |             | _     | 0       |
| KGFN       |             | _     | 0       |
| KJF        |             | _     | 0       |
| KKP        |             | _     | 0       |
| KP         |             | _     | 0.0005  |
| KRGL1      |             | _     | 0       |
|            |             |       |         |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| KUCRIT    |             | _     | 0       |
| KVTO      |             | _     | 0       |
| LA        |             | _     | 1       |
| LAMBDA    |             | _     | 0.5     |
| LB        |             | _     | 1       |
| LDIF      |             | _     | 0       |
| LDPHIEDGE |             | _     | 0       |
| LDW       |             | _     | 0       |
| LETA      |             | _     | 0.5     |
| LETA0     |             | _     | 0       |
| LETA2     |             | _     | 0       |
| LGAM      |             | _     | 1       |
| LKKP      |             | _     | 0       |
| LKVTO     |             | _     | 0       |
| LL        |             | _     | 0       |
| LLN       |             | _     | 1       |
| LLODKKP   |             | _     | 1       |
| LLODKVTO  |             | _     | 1       |
| LNWR      |             | _     | 0       |
| LODKETAD  |             | _     | 1       |
| LODKGAMMA |             | _     | 1       |
| LOV       |             | _     | 2e-08   |
| LOVIG     |             | _     | 2e-08   |
| LQWR      |             | _     | 0       |
| LR        |             | _     | 5e-08   |
| LVT       |             | _     | 1       |
| LWR       |             | _     | 0       |
| MJD       |             | _     | 0.9     |
| MJS       |             | _     | 0.9     |
| MJSWD     |             | _     | 0.7     |
| MJSWGD    |             | _     | 0.7     |
| MJSWGS    |             | _     | 0.7     |
| MJSWS     |             | -     | 0.7     |
| N0        |             | _     | 1       |
| NCS       |             | _     | 1       |
| NFVTA     |             | _     | 0       |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter | Description          | Units | Default |
|-----------|----------------------|-------|---------|
| NFVTB     |                      | -     | 10000   |
| NJD       |                      | _     | 1       |
| NJS       |                      | _     | 1       |
| NJTSD     |                      | _     | 1       |
| NJTSS     |                      | _     | 1       |
| NJTSSWD   |                      | _     | 1       |
| NJTSSWGD  |                      | _     | 1       |
| NJTSSWGS  |                      | _     | 1       |
| NJTSSWS   |                      | _     | 1       |
| NLR       |                      | -     | 0.01    |
| NQS_NOI   |                      | _     | 1       |
| NWR       |                      | -     | 0.005   |
| PBD       |                      | _     | 0.8     |
| PBS       |                      | _     | 0.8     |
| PBSWD     |                      | _     | 0.6     |
| PBSWGD    |                      | _     | 0.6     |
| PBSWGS    |                      | _     | 0.6     |
| PBSWS     |                      | -     | 0.6     |
| PDITS     |                      | _     | 0       |
| PDITSD    |                      | _     | 1       |
| PDITSL    |                      | _     | 0       |
| PHIF      | FERMI BULK POTENTIAL | _     | 0.45    |
| PKKP      |                      | _     | 0       |
| PKVTO     |                      | _     | 0       |
| QLR       |                      | _     | 0.0005  |
| QOFF      |                      | _     | 0       |
| QWR       |                      | _     | 0.0003  |
| RBN       |                      | _     | 0       |
| RBWSH     |                      | _     | 0.003   |
| RD        |                      | _     | 0       |
| RDBN      |                      | _     | 0       |
| RDBWSH    |                      | _     | 0.001   |
| RDSBSH    |                      | _     | 1000    |
| RDX       |                      | _     | -1      |
| RGSH      |                      | _     | 3       |
|           |                      |       |         |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| RLX       | EXTERNAL SERIES RESISTANCE                             | _     | -1      |
| RS        |  | _     | 0       |
| RSBN      |  | _     | 0       |
| RSBWSH    |  | _     | 0.001   |
| RSH       |  | _     | 0       |
| RSX       |  | _     | -1      |
| SAREF     |  | _     | 0       |
| SBREF     |  | _     | 0       |
| SCALE     |  | _     | 1       |
| SIGMAD    |  | -     | 1       |
| SIGN      | SIGN = 1 FOR NMOS; SIGN = -1 FOR PMOS                  | _     | 1       |
| TCJ       |  | -     | 0       |
| TCJSW     |  | _     | 0       |
| TCJSWG    |  | _     | 0       |
| TCV       |  | -     | 0.0006  |
| TCVL      |  | -     | 0       |
| TCVW      |  | _     | 0       |
| TCVWL     |  | _     | 0       |
| TE0EX     |  | _     | 0.5     |
| TE1EX     |  | _     | 0.5     |
| TETA      |  | _     | -0.0009 |
| TG        | TYPE OF GATE: -1 ENHANCEMENT TYPE; 1<br>DEPLETION TYPE | _     | -1      |
| TH_NOI    |  | _     | 0       |
| THC       |  | _     | 0       |
| TKKP      |  | -     | 0       |
| TLAMBDA   |  | -     | 0       |
| TNJTSD    |  | -     | 0       |
| TNJTSS    |  | _     | 0       |
| TNJTSSWD  |  | -     | 0       |
| TNJTSSWGD |  | -     | 0       |
| TNJTSSWGS |  | _     | 0       |
| TNJTSSWS  |  | _     | 0       |
| TNOM      |  | _     | 27      |
| TPB       |  | _     | 0       |
| TPBSW     |  | _     | 0       |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter Description | Units    | Default |
|-----------------------|----------|---------|
| TPBSWG                | _        | 0       |
| TR                    | -        | 0       |
| TR2                   | _        | 0       |
| UCEX                  | -        | 1.5     |
| UCRIT                 | -        | 5e+06   |
| VBI                   | -        | 0       |
| VFBOV                 | -        | 0       |
| VFR                   | -        | 0       |
| VOV                   | -        | 1       |
| VTO THRESHOLD VO      | DLTAGE – | 0.3     |
| VTSD                  | -        | 0       |
| VTSS                  | -        | 0       |
| VTSSWD                | -        | 0       |
| VTSSWGD               | -        | 0       |
| VTSSWGS               | -        | 0       |
| VTSSWS                | -        | 0       |
| WDL                   | -        | 0       |
| WDPHIEDGE             | -        | 0       |
| WEO                   | -        | 0       |
| WE1                   | _        | 0       |
| WEDGE                 | -        | 0       |
| WETA                  | _        | 0.2     |
| WETAD                 | -        | 0       |
| WGAM                  | -        | 1       |
| WKKP                  | _        | 0       |
| WKP1                  | -        | 1e-06   |
| WKP2                  | _        | 0       |
| WKP3                  | -        | 1       |
| WKVTO                 | -        | 0       |
| WLAMBDA               | -        | 0       |
| WLDGAMMAEDGE          | -        | 0       |
| WLDPHIEDGE            | -        | 0       |
| WLOD                  | -        | 0       |
| WLODKKP               | -        | 1       |
| WLODKVTO              | -        | 1       |
| WLR                   | _        | 0       |

Table 2-139. EKV3 MOSFET Device Model Parameters

| Parameter | Description | Units | Default |
|-----------|-------------|-------|---------|
| WNLR      |             | _     | 0       |
| WQLR      |             | _     | 0       |
| WR        |             | _     | 9e-08   |
| WRLX      |             | _     | 0       |
| WUCEX     |             | _     | 0       |
| WUCRIT    |             | _     | 0       |
| WVT       |             | _     | 1       |
| XB        |             | _     | 3.1     |
| XJ        |             | _     | 2e-08   |
| XJBVD     |             | _     | 0       |
| XJBVS     |             | _     | 0       |
| XL        |             | _     | 0       |
| XTID      |             | _     | 3       |
| XTIS      |             | _     | 3       |
| XTSD      |             | _     | 0       |
| XTSS      |             | _     | 0       |
| XTSSWD    |             | _     | 0       |
| XTSSWGD   |             | _     | 0       |
| XTSSWGS   |             | -     | 0       |
| XTSSWS    |             | _     | 0       |
| XW        |             | _     | 0       |
| ZC        |             | _     | 1e-06   |

## 2.3.20.18. Level 10240 MOSFET Tables (L\_UTSOI Version 102.4.0)

Select Xyce binaries include the L\_UTSOI MOSFET model as the level 10240 MOSFET. This model's parameters and output variables are listed in tables 2-140, 2-141, and 2-142

Table 2-140. L\_UTSOI MOSFET Device Instance Parameters

| Parameter | Description                                      | Units          | Default |
|-----------|--|----------------|---------|
| ADRAIN    | Drain region area                                | $m^2$          | 1e-12   |
| ASOURCE   | Source region area                               | m <sup>2</sup> | 1e-12   |
| DELVTO    | Threshold voltage shift parameter                | V              | 0       |
| FACTUO    | Low-field mobility pre-factor                    | _              | 1       |
| L         | Channel length                                   | m              | 1e-06   |
| М         | multiplicity factor                              | _              | 1       |
| MULT      | Number of devices in parallel                    | _              | 1       |
| NF        | Number of fingers                                | _              | 1       |
| PDRAIN    | Drain region perimeter                           | m              | 1e-06   |
| PSOURCE   | Source region perimeter                          | m              | 1e-06   |
| SA        | Distance between OD-edge and poly at source side | m              | 0       |
| SB        | Distance between OD-edge and poly at drain side  | m              | 0       |
| SD        | Distance between neighboring fingers             | m              | 0       |
| W         | Channel width                                    | m              | 1e-06   |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units            | Default |
|-----------|--|------------------|---------|
| A1        | Impact ionization pre-factor                             |                  | 1       |
| A1L       | Length dependence of A1                                  | _                | 0       |
| A10       | Geometry independent impact ionization pre-factor        |                  | 1       |
| A1W       | Width dependence of A1                                   |                  | 0       |
| A2        | Impact ionization exponent at TR                         |                  | 10      |
| A20       | Impact ionization exponent at TR                         |                  | 10      |
| A3        | Saturation voltage dependence of impact-ionization       |                  | 1       |
| A3L       | Length dependence of A3                                  |                  | 0       |
| A30       | Geometry independent saturation-voltage dependence of II |                  | 1       |
| A3W       | Width dependence of A3                                   |                  | 0       |
| AGIDL     | GIDL pre-factor  | A/V <sup>3</sup> | 0       |
| AGIDLD    | GIDL pre-factor at drain side                            | A/V <sup>3</sup> | 0       |
| AGIDLDO   | GIDL geometry independent pre-factor at drain side       | A/V <sup>3</sup> | 0       |
| AGIDLDW   | GIDL pre-factor for a width of WEN at drain side         | A/V <sup>3</sup> | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units                | Default |
|-----------|--|----------------------|---------|
| AGIDLO    | GIDL geometry independent pre-factor                             | $A/V^3$              | 0       |
| AGIDLW    | GIDL pre-factor for a width of WEN                               | A/V <sup>3</sup>     | 0       |
| ALP       | CLM pre-factor   | _                    | 0       |
| ALP1      | CLM enhancement factor above threshold                           | V                    | 0       |
| ALP1L1    | Length dependence of CLM enhancement factor above threshold ALP1 | V                    | 0       |
| ALP1L2    | Second order length dependence of ALP1                           | _                    | 0       |
| LP1LEXP   | Exponent for length dependence of ALP1                           | _                    | 0.5     |
| ALP1LEXP2 | Exponent for second order length dependence of ALP1              | _                    | 1.5     |
| ALP1W     | Width dependence of ALP1   | _                    | 0       |
| ALPB      | Back bias dependence of channel length modulation                | _                    | 0       |
| ALPBO     | Back bias dependence of channel length modulation                | _                    | 0       |
| ALPL1     | Length dependence of CLM pre-factor ALP                          | _                    | 0       |
| ALPL2     | Second order length dependence of ALP                            | _                    | 0       |
| ALPLEXP   | Exponent for length dependence of ALP                            | _                    | 1       |
| ALPLEXP2  | Exponent for second order length dependence of ALP               | _                    | 2       |
| ALPW      | Width dependence of ALP  | _                    | 0       |
| AREAQ     | Effective channel area for intrinsic CV                          | m <sup>2</sup>       | 1e-12   |
| ΑX        | Linear/saturation transition exponent                            | _                    | 8       |
| XL        | Length dependence of AX  | _                    | 0       |
| AXL2      | Second order length dependence of AX                             | _                    | 0       |
| AXLEXP    | Exponent for length dependence of AX                             | _                    | 1       |
| AXLEXP2   | Exponent for second order length dependence of AX                | _                    | 1.5     |
| AXO       | Geometry independent linear/saturation transition exponent       | _                    | 8       |
| BETN      | Front channel aspect ratio times zero-field mobility             | m <sup>2</sup> /(Vs) | 0.05    |
| BETNB     | Back channel over front channel zero-field mobility ratio        | _                    | 1       |
| BETNBO    | Back channel over front channel zero-field mobility ratio        |                      | 1       |
| BETW1     | First width dependence modulation of BETN                        | _                    | 0       |
| BETW2     | Second width dependence modulation of BETN                       | _                    | 0       |
| BGIDL     | GIDL probability factor at TR                                    | V                    | 41      |
| BGIDLD    | GIDL probability factor at TR at drain side                      | V                    | 41      |
| BGIDLDO   | GIDL probability factor at TR at drain side                      | V                    | 41      |
| BGIDLO    | GIDL probability factor at TR                                    | V                    | 41      |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units    | Default |
|-----------|--|----------|---------|
| CF        | DIBL parameter   |          | 0       |
| CFB       | DIBL back to front interface asymmetry factor                                |          | 1       |
| CFBO      | DIBL back to front interface asymmetry factor                                | _        | 1       |
| CFD       | Drain voltage dependence parameter of DIBL                                   | V        | 0.2     |
| CFDL      | DIBL modulation coefficient due to Leff variation                            | _        | 0       |
| CFDLB     | Back bias dependence of DIBL modulation                                      | _        | 0       |
| CFDLBO    | Back bias dependence of DIBL modulation                                      |          | 0       |
| CFDLL     | DIBL modulation coefficient due to Leff variation                            | _        | 0       |
| CFDLW     | Width dependence of CFDL   | _        | 0       |
| CFDO      | Drain voltage dependence parameter of DIBL                                   | V        | 0.2     |
| CFL       | Length dependence of DIBL-parameter  | _        | 0       |
| CFLEXP    | Exponent for length dependence of CF   | _        | 2       |
| CFR       | Outer fringe capacitance per side  | F        | 0       |
| CFRD      | Outer fringe capacitance at drain side                                       | F        | 0       |
| CFRDO     | Corner related outer fringe capacitance at drain side                        | F        | 0       |
| CFRDW     | Outer fringe capacitance per side for a width of WEN at drain side           | F        | 0       |
| CFRO      | Corner related outer fringe capacitance                                      | F        | 0       |
| CFRW      | Outer fringe capacitance per side for a width of WEN                         | F        | 0       |
| CFW       | Width dependence of CF   | _        | 0       |
| CGBOV     | Oxide capacitance for gate-substrate overlap                                 | F        | 0       |
| CGBOVL    | Length dependent gate-substrate overlap capacitance part for a length of LEN | F        | 0       |
| CGBOVO    | Geometry independent gate-substrate overlap capacitance part                 | F        | 0       |
| CGIDL     | Substrate bias dependence of GIDL  | $V^{-1}$ | 0       |
| CGIDLD    | Substrate bias dependence of GIDL at drain side                              | $V^{-1}$ | 0       |
| CGIDLDO   | Substrate bias dependence of GIDL at drain side                              | $V^{-1}$ | 0       |
| CGIDLO    | Substrate bias dependence of GIDL  | $V^{-1}$ | 0       |
| CHIB      | Tunneling barrier height   | V        | 3.1     |
| CHIBO     | Tunneling barrier height   | V        | 3.1     |
| CIC       | Long channel back interface coupling coefficient                             | _        | 1       |
| CICF      | Long channel front interface coupling coefficient                            | _        | 1       |
| CICFO     | Long channel front interface coupling coefficient                            |          | 1       |
| CICO      | Long channel back interface coupling coefficient                             | _        | 1       |
| COV       | Overlap capacitance per side   | F        | 0       |
| COVD      | Overlap capacitance at drain side  | F        | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units    | Default  |
|-----------|--|----------|----------|
| COVDL     | Overlap capacitance modulation coefficient due to Leff variation | _        | 0        |
| COVDLB    | Overlap capacitance modulation with back bias                    | _        | 0        |
| COVDLBO   | Overlap capacitance modulation with back bias                    | _        | 0        |
| COVDLO    | Overlap capacitance modulation coefficient due to Leff variation | _        | 0        |
| COVDLW    | Width dependence of COVDL  | _        | 0        |
| CS        | Remote Coulomb scattering parameter at TR                        | _        | 0        |
| CSBI      | Field dependence of Coulomb scattering at back interface         | _        | 0        |
| CSBIO     | Field dependence of Coulomb scattering at back interface         | _        | 0        |
| CSD       | Drain-source capacitance   | F        | 1.04e-18 |
| CSDBP     | Drain/source to substrate perimeter capacitance                  | _        | 0        |
| CSDBPO    | Drain/source to substrate perimeter capacitance                  | _        | 0        |
| CSDO      | Drain-source capacitance correction factor                       | _        | 1        |
| CSFI      | Field dependence of Coulomb scattering at front interface        | _        | 0        |
| CSFIO     | Field dependence of Coulomb scattering at front interface        | _        | 0        |
| CSL       | Length dependence of CS  | _        | 0        |
| CSLEXP    | Exponent describing length dependence of CS                      | _        | 1        |
| CSLW      | Area dependence of CS  | _        | 0        |
| CSO       | Remote Coulomb scattering parameter at TR                        | _        | 0        |
| CSTHR     | Remote Coulomb scattering threshold level                        | _        | 2        |
| CSTHRB    | Remote Coulomb scattering threshold asymmetry parameter          | _        | 1        |
| CSTHRBO   | Remote Coulomb scattering threshold asymmetry parameter          | _        | 1        |
| CSTHRO    | Remote Coulomb scattering threshold level                        | _        | 2        |
| CSW       | Width dependence of CS   | _        | 0        |
| CT        | Interface states factor  | _        | 0        |
| CTH       | Thermal capacitance  | _        | 1e-11    |
| CTHO      | Geometry independent thermal capacitance                         | _        | 1e-12    |
| CTO       | Interface states factor  | _        | 0        |
| DGIDL     | High longitudinal field parameter of GIDL                        | $V^{-1}$ | 0        |
| DGIDLD    | High longitudinal field parameter of GIDL at drain side          | $V^{-1}$ | 0        |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter  | Description  | Units    | Default |
|------------|--|----------|---------|
| DGIDLDL    | High longitudinal field parameter of GIDL at drain side                                | $V^{-1}$ | 0       |
| DGIDLDO    | High field geometry independent parameter of GIDL at drain side                        | $V^{-1}$ | 0       |
| DGIDLL     | High longitudinal field parameter of GIDL  | $V^{-1}$ | 0       |
| DGIDLO     | High field geometry independent parameter of GIDL                                      | $V^{-1}$ | 0       |
| DLQ        | Effective channel length additional offset for charge model                            | m        | 0       |
| DVFBOV     | Overlap capacitance flat-band voltage adjustment                                       | V        | 0       |
| DVFBOVO    | Overlap capacitance flat-band voltage adjustment                                       | V        | 0       |
| DWQ        | Effective channel width additional offset for charge model                             | m        | 0       |
| EF         | Frequency coefficient of flicker noise   | _        | 1       |
| EFO        | Frequency coefficient of flicker noise   | _        | 1       |
| FBET1      | First length dependence modulation of BETN   | _        | 0       |
| FBET1W     | Width dependence of FBET1  | _        | 0       |
| FBET2      | Second length dependence modulation of BETN  | _        | 0       |
| FETA       | Effective field parameter  |          | 1       |
| FETAO      | Effective field parameter  | _        | 1       |
| FIF        | Inner fringe capacitance prefactor   | _        | 0       |
| FIFW       | Inner fringe capacitance prefactor for a width of WEN                                  | _        | 0       |
| FNOVINV    | Extra gate to overlap current pre-factor in inversion                                  | A        | 0       |
| FNOVINVD   | Extra gate to overlap current pre-factor in inversion at drain side                    | A        | 0       |
| FNOVINVDW  | Extra gate to overlap current pre-factor for a width of WEN in inversion at drain side | A        | 0       |
| FNOVINVW   | Extra gate to overlap current pre-factor for a width of WEN in inversion               | A        | 0       |
| FNT        | Thermal noise coefficient  | _        | 1       |
| FNTEXC     | Excess noise coefficient   | _        | 0       |
| FNTEXCL    | Length dependence coefficient of excess noise  | _        | 0       |
| FNTEXCLEXP | Length dependence exponent of excess noise   | _        | 2       |
| FNTO       | Thermal noise coefficient  | _        | 1       |
| FSCEAC     | Short channel effect adjustment factor for charge model                                | _        | 0       |
| FSCEACO    | Short channel effect adjustment factor for charge model                                | _        | 0       |
| FTHO       | First neighbour thermal coupling factor for multifinger devices                        | _        | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter  | Description   | Units    | Default |
|------------|---|----------|---------|
| GC2CH      | Gate to channel current slope factor  | _        | 0.375   |
| GC2CHO     | Gate to channel current slope factor  |          | 0.375   |
| GC20VACC   | Gate current slope factor for overlap regions in accumulation mode                  | _        | 0.375   |
| GC20VACCO  | Gate current slope factor for overlap regions in accumulation mode                  | _        | 0.375   |
| GC2OVINV   | Gate current slope factor for overlap regions in inversion mode                     | _        | 0.375   |
| GC2OVINVO  | Gate current slope factor for overlap regions in inversion mode                     | _        | 0.375   |
| GC3CH      | Gate to channel current curvature factor  | _        | 0.063   |
| GC3CHO     | Gate to channel current curvature factor  |          | 0.063   |
| GC30VACC   | Gate current curvature factor for overlap regions in accumulation mode              |          | 0.063   |
| GC30VACC0  | Gate current curvature factor for overlap regions in accumulation mode              |          | 0.063   |
| GC30VINV   | Gate current curvature factor for overlap regions in inversion mode                 | _        | 0.063   |
| GC30VINVO  | Gate current curvature factor for overlap regions in inversion mode                 | _        | 0.063   |
| GCDOV      | High drain voltage dependence of overlap gate current                               | $V^{-1}$ | 0       |
| GCDOVL     | High drain voltage dependence of overlap gate current                               | $V^{-1}$ | 0       |
| GCO        | Gate tunneling energy adjustment in inversion                                       | _        | 0       |
| GCOO       | Gate tunneling energy adjustment in inversion                                       | _        | 0       |
| GCOVINVFN  | Extra gate current slope factor for overlap regions in inversion mode               | _        | 0.2     |
| GCOVINVFNO | Extra gate current slope factor for overlap regions in inversion mode               | _        | 0.2     |
| GCVDOV     | Threshold of high drain voltage effect on overlap gate current                      | V        | 1       |
| GCVDOVO    | Threshold of high drain voltage effect on overlap gate current                      | V        | 1       |
| IGINV      | Gate to channel current pre-factor  | A        | 0       |
| IGINVLW    | Gate to channel current pre-factor for a channel area of WEN.LEN                    | A        | 0       |
| IGOVACC    | Gate to overlap current pre-factor in accumulation                                  | A        | 0       |
| IGOVACCD   | Gate to overlap current pre-factor in accumulation at drain side                    | A        | 0       |
| IGOVACCDW  | Gate to overlap current pre-factor for a width of WEN in accumulation at drain side | A        | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| IGOVACCW  | Gate to overlap current pre-factor for a width of WEN in accumulation            | A     | 0       |
| IGOVINV   | Gate to overlap current pre-factor in inversion                                  | A     | 0       |
| IGOVINVD  | Gate to overlap current pre-factor in inversion at drain side                    | A     | 0       |
| IGOVINVDW | Gate to overlap current pre-factor for a width of WEN in inversion at drain side | A     | 0       |
| IGOVINVW  | Gate to overlap current pre-factor for a width of WEN in inversion               | A     | 0       |
| KUO       | Mobility degradation/enhancement coefficient                                     | m     | 0       |
| KVSAT     | Saturation velocity degradation/enhancement coefficient                          | _     | 0       |
| KVTHO     | Threshold shift parameter  | Vm    | 0       |
| LAMBTHO   | Characteristic length of lateral thermal coupling for multifinger devices        | m     | 1e-07   |
| LAP       | Effective channel length reduction per side                                      | m     | 0       |
| LKUO      | Length dependence of KUO   | _     | 0       |
| LKVTHO    | Length dependence of KVTHO   | _     | 0       |
| LLODKUO   | Length parameter for UO stress effect  | _     | 0       |
| LLODVTH   | Length parameter for VTH-stress effect   | _     | 0       |
| LODETAO   | Eta0 shift modification factor for stress effect                                 | _     | 1       |
| LOVDO     | Overlap length for gate/drain hdd overlap capacitance                            | m     | 0       |
| LOVO      | Overlap length for gate/source-drain hdd overlap capacitance                     | m     | 0       |
| LP1       | First characteristic length of BETN scaling                                      | m     | 1e-08   |
| LP1W      | Width dependence of LP1  | _     | 0       |
| LP2       | Second characteristic length of BETN scaling                                     | m     | 1e-08   |
| LVARL     | Length dependence of LPS   | _     | 0       |
| LVARO     | Geometry independent difference between physical and drawn gate lengths          | m     | 0       |
| LVARW     | Width dependence of LPS  | _     | 0       |
| MUE       | Front channel mobility reduction coefficient at TR                               | _     | 0       |
| MUEO      | Front channel mobility reduction coefficient at TR                               | _     | 0       |
| NCH       | Thin film doping (n-type=negative value, p-type=positive value)                  | _     | 0       |
| NCHO      | Thin film doping (n-type=negative value, p-type=positive value)                  | _     | 0       |
| NFA       | First coefficient of flicker noise   | _     | 8e+22   |
|           |  |       |         |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description   | Units    | Default |
|-----------|---|----------|---------|
| NFAW      | Long channel first coefficient of flicker noise                 |          | 0       |
| NFB       | Second coefficient of flicker noise                             | _        | 3e+07   |
| NFBLW     | Second coefficient of flicker noise                             | _        | 3e+07   |
| NFC       | Third coefficient of flicker noise                              | $V^{-1}$ | 0       |
| NFCLW     | Third coefficient of flicker noise                              | $V^{-1}$ | 0       |
| NFE       | Flicker noise front transverse field effect coefficient         | _        | 0       |
| NFEB      | Flicker noise back transverse field effect coefficient          | _        | 0       |
| NFEBO     | Flicker noise back transverse field effect coefficient          | _        | 0       |
| NFEO      | Flicker noise front transverse field effect coefficient         | _        | 0       |
| NIGINV    | Gate tunneling slope adjustment in subthreshold regime          | _        | 0       |
| NIGINVO   | Gate tunneling slope adjustment in subthreshold regime          | _        | 0       |
| NOV       | Effective doping of overlap-ldd regions                         | _        | 1e+20   |
| NOVD      | Effective doping of overlap-ldd regions ar drain side           | _        | 1e+20   |
| NOVDO     | Effective doping of overlap-ldd regions at drain side           | _        | 1e+20   |
| NOVO      | Effective doping of overlap-ldd regions                         | _        | 1e+20   |
| NSDAC     | Source/Drain effective doping level for AC model                | _        | 1e+22   |
| NSDACO    | Source/Drain effective doping level for AC model                | _        | 1e+22   |
| NSDDC     | Source/Drain effective doping level for DC model                | _        | 1e+22   |
| NSDDCO    | Source/Drain effective doping level for DC model                | _        | 1e+22   |
| NSUB      | Substrate doping (n-type=negative value, p-type=positive value) | _        | 3e+18   |
| NSUBO     | Substrate doping (n-type=negative value, p-type=positive value) | _        | 3e+18   |
| PKUO      | Cross-term dependence of KUO                                    | _        | 0       |
| PKVTHO    | Cross-term dependence of KVTHO                                  | _        | 0       |
| PNCE      | Narrow channel effect on body factor                            |          | 0       |
| PNCEW     | Narrow channel effect on body factor for a width of WEN         | _        | 0       |
| PSCE      | Short channel effect coefficient                                |          | 0       |
| PSCEB     | Short channel back to front interface asymmetry factor          | _        | 1       |
| PSCEBO    | Short channel back to front interface asymmetry factor          | _        | 1       |
| PSCEDLB   | Back bias dependence of short channel effect modulation         | _        | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| PSCEDLBO  | Back bias dependence of short channel effect modulation        | _     | 0       |
| PSCEL     | Length dependence of PSCE                                      | _     | 0       |
| PSCELEXP  | Exponent describing length dependence of PSCE                  | _     | 2       |
| PSCEW     | Width dependence of PSCE                                       | _     | 0       |
| QMC       | Quantum correction factor (no correction=0, full correction=1) | _     | 1       |
| RS        | Source/Drain series resistance at TR                           | Ω     | 30      |
| RSB       | Back bias dependence of RS                                     | _     | 0       |
| RSB0      | Back bias dependence of RS                                     | _     | 0       |
| RSG       | Transverse electric field dependence of RS                     | _     | 0       |
| RSGO      | Transverse electric field dependence of RS                     | _     | 0       |
| RSIG      | Source/Drain extension resistance coefficient                  | _     | 0       |
| RSIGO     | Source/Drain extension resistance coefficient                  | _     | 0       |
| RSW1      | Source/Drain series resistance for channel width WEN at TR     | Ω     | 30      |
| RSW2      | Higher-order width scaling of source/drain series resistance   | _     | 0       |
| RTH       | Thermal resistance   | _     | 10000   |
| RTHL      | Length dependence of RTH                                       | _     | 1.5     |
| RTHLW     | Area dependence of RTH   | _     | 4.5     |
| RTHO      | Geometry independent thermal resistance                        | _     | 100000  |
| RTHW      | Width dependence of RTH  | _     | 3       |
| SAREF     | Reference distance between OD-edge and poly from one side      | m     | 1e-06   |
| SBREF     | Reference distance between OD-edge and poly from other side    | m     | 1e-06   |
| STA2      | Temperature dependence of A2                                   | _     | 0       |
| STA20     | Temperature dependence of A2                                   | _     | 0       |
| STBET     | Temperature dependence of BETN                                 | _     | 1.5     |
| STBETL    | Length dependence of STBET                                     | _     | 0       |
| STBETLW   | Area dependence of STBET                                       | _     | 0       |
| STBETO    | Geometry independent temperature dependence of BETN            | _     | 1.5     |
| STBETW    | Width dependence of STBET                                      | _     | 0       |
| STBGIDL   | Temperature dependence of BGIDL                                | V/K   | 0       |
| STBGIDLD  | Temperature dependence of BGIDL at drain side                  | V/K   | 0       |
| STBGIDLDO | Temperature dependence of BGIDL at drain side                  | V/K   | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| STBGIDLO  | Temperature dependence of BGIDL  | V/K   | 0       |
| STCF      | Temperature dependence of CF, with same scaling as CF                  | 1/K   | 0       |
| STCFL     | Temperature dependence of CF, with same scaling as CF                  | 1/K   | 0       |
| STCS      | Temperature dependence of CS   | _     | 0       |
| STCSL     | Length dependence of STCS  | _     | 0       |
| STCSLW    | Area dependence of STCS  | _     | 0       |
| STCSO     | Temperature dependence of CS   | _     | 0       |
| STCSW     | Width dependence of STCS   | _     | 0       |
| STETAO    | Eta0 shift factor related to VTHO change                               | m     | 0       |
| STIG      | Temperature dependence of all gate currents                            | _     | 0       |
| STIGFN    | Temperature dependence of extra gate to overlap current                | _     | 0       |
| STIGFNO   | Temperature dependence of extra gate to overlap current                | _     | 0       |
| STIGO     | Temperature dependence of all gate currents                            | _     | 0       |
| STMUE     | Temperature dependence of MUE  | _     | 0       |
| STMUEO    | Temperature dependence of MUE  | _     | 0       |
| STRALPHA  | Asymmetry parameter  | _     | 3       |
| STRDCFL   | DIBL variation parameter   | _     | 0       |
| STRDVFBO  | Threshold shift parameter  | V     | 0       |
| STRLAMBDA | Relaxation characteristic length                                       | m     | 1e-07   |
| STRRUO    | Mobility degradation/enhancement coefficient                           | _     | 0       |
| STRRVSAT  | Saturation velocity degradation/enhancement coefficient                | _     | 0       |
| STRS      | Temperature dependence of RS   | _     | 0       |
| STRSO     | Temperature dependence of RS   | _     | 0       |
| STRTH     | Temperature dependence of RTH  | _     | 0       |
| STRTHO    | Temperature dependence of RTH  |       | 0       |
| STRTRUO   | Temperature dependence of mobility degradation/enhancement coefficient | _     | 0       |
| STRWDVFBO | Width dependence of threshold shift parameter                          | _     | 0       |
| STTHECS   | Temperature dependence of THECS  | _     | 0       |
| STTHECSO  | Temperature dependence of THECS  | _     | 0       |
| STTHEMU   | Temperature dependence of THEMU  | _     | 0       |
| STTHEMUO  | Temperature dependence of THEMU  | _     | 0       |
| STTHESAT  | Temperature dependence of THESAT                                       | _     | -0.1    |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter  | Description   | Units    | Default |
|------------|---|----------|---------|
| STTHESATL  | Length dependence of STTHESAT   | _        | 0       |
| STTHESATLW | Area dependence of STTHESAT   | _        | 0       |
| STTHESATO  | Geometry independent temperature dependence of THESAT   | _        | -0.1    |
| STTHESATW  | Width dependence of STTHESAT  | _        | 0       |
| STVFB      | Temperature dependence of VFB and VFBB  | V/K      | 0       |
| STVFBL     | Length dependence of STVFB  | _        | 0       |
| STVFBLW    | Area dependence of STVFB  | _        | 0       |
| STVFBO     | Geometry-independent temperature dependence of VFB and VFBB   | V/K      | 0       |
| STVFBW     | Width dependence of STVFB   | _        | 0       |
| STXCOR     | Temperature dependence of XCOR  | _        | 0       |
| STXCORO    | Temperature dependence of XCOR  | _        | 0       |
| SWGIDL     | Flag for GIDL current (without=0, with=1)   | _        | 0       |
| SWIGATE    | Flag for gate current (without=0, with=1)   |          | 0       |
| SWIGN      | Flag for induced gate noise model (without=0, with=1)   | _        | 1       |
| SWIMPACT   | Flag for impact ionization current (without=0, with=1)  | _        | 0       |
| SWJUNASYM  | Flag for source/drain junction asymmetry (without=0, with=1)  | _        | 0       |
| SWSCALE    | Parameter set mode (local=0, global=1)  | _        | 0       |
| SWSHE      | Flag for self heating effect (without=0, with=1)  | _        | 0       |
| SWSTRESS   | Stress model selection flag: 0=disable, 1=classical STI stress model, 2=strained channel stress model | _        | 1       |
| SWSUBDEP   | Flag for substrate depletion model (without=0, with=1)  | _        | 0       |
| TBOX       | Buried oxide thickness  | m        | 1e-07   |
| IBOXO      | Buried oxide thickness  | m        | 1e-07   |
| THECS      | Remote Coulomb scattering exponent at TR  | _        | 1.5     |
| THECSO     | Remote Coulomb scattering exponent at TR  | _        | 1.5     |
| THEMU      | Front channel mobility reduction exponent at TR   | _        | 1.5     |
| THEMUO     | Front channel mobility reduction exponent at TR   | _        | 1.5     |
| THERSG     | Transverse electric field dependence exponent of RS   | _        | 2       |
| THERSGO    | Transverse electric field dependence exponent of RS   | _        | 2       |
| THESAT     | Velocity saturation parameter at TR   | $V^{-1}$ | 0       |
| THESATB    | Back gate bias dependence of velocity saturation  | _        | 0       |
| THESATBO   | Back gate bias dependence of velocity saturation  | _        | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter  | Description  | Units                | Default |
|------------|--|----------------------|---------|
| THESATG    | Front gate bias dependence of velocity saturation            | _                    | 0       |
| THESATGO   | Front gate bias dependence of velocity saturation            | _                    | 0       |
| THESATL    | Length dependence of THESAT                                  | _                    | 0       |
| THESATLEXP | Exponent for length dependence of THESAT                     | _                    | 1       |
| THESATLW   | Area dependence of THESAT                                    |                      | 0       |
| THESATO    | Geometry independent velocity saturation parameter at TR     | _                    | 0       |
| THESATW    | Width dependence of THESAT                                   | _                    | 0       |
| TKUO       | Temperature dependence of KUO                                | _                    | 0       |
| TMAX       | Maximum self-heating temperature elevation                   | C                    | 150     |
| TOXE       | Front gate equivalent oxide thickness                        | m                    | 2e-09   |
| TOXEO      | Front gate equivalent oxide thickness                        | m                    | 2e-09   |
| TOXP       | Front gate physical oxide thickness                          | m                    | 2e-09   |
| TOXPO      | Front gate physical oxide thickness                          | m                    | 2e-09   |
| TR         | Nominal temperature  | С                    | 21      |
| TSI        | Silicon or SiGe film thickness                               | m                    | 1e-08   |
| TSIO       | Silicon or SiGe film thickness                               | m                    | 1e-08   |
| TYPE       | Channel type parameter, +1=NMOS -1=PMOS                      |                      | 1       |
| UO         | Front channel zero-field mobility at TR                      | m <sup>2</sup> /(Vs) | 0.05    |
| VERSION    | Model version  | _                    | 102.4   |
| VFB        | Flat-band voltage of the front gate at TR                    | V                    | 0       |
| VFBB       | Flat-band voltage of the back gate at TR                     | V                    | 0       |
| VFBBO      | Geometry-independent back gate flat-band voltage at TR       | V                    | 0       |
| VFBL       | Length dependence of VFB                                     | V                    | 0       |
| VFBL2      | Second order length dependence of VFB                        | _                    | 0       |
| VFBLBO     | Roll-off back to front interface asymmetry factor            | _                    | 0       |
| VFBLEXP    | Exponent describing length dependence of VFB                 | _                    | 2       |
| VFBLEXP2   | Exponent of second order length dependence of VFB            | _                    | 2       |
| VFBLW      | Area dependence of VFB                                       | V                    | 0       |
| VFBO       | Geometry-independent front gate flat-band voltage at TR      | V                    | 0       |
| VFBW       | Width dependence of VFB                                      | V                    | 0       |
| VP         | CLM logarithm dependence factor                              | V                    | 0.05    |
| VPG        | Transverse electric field dependence of CLM logarithm factor | _                    | 0       |

Table 2-141. L\_UTSOI MOSFET Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| VPGO      | Transverse electric field dependence of CLM logarithm factor                   | _     | 0       |
| VPO       | CLM logarithm dependence factor  | V     | 0.05    |
| WBET      | Characteristic width of BETN scaling   | m     | 1e-08   |
| WKUO      | Width dependence of KUO  | _     | 0       |
| WKVTHO    | Width dependence of KVTHO  | _     | 0       |
| WLOD      | Width parameter  | m     | 0       |
| WLODKUO   | Width parameter for UO stress effect   | _     | 0       |
| WLODVTH   | Width parameter for VTH-stress effect  | _     | 0       |
| WOT       | Effective reduction of channel width per side                                  | m     | 0       |
| WVARL     | Length dependence of WOD   | _     | 0       |
| WVARO     | Geometry-independent difference between physical and drawn field-oxide opening | m     | 0       |
| WVARW     | Width dependence of WOD  | _     | 0       |
| XCOR      | Front channel non-universality factor  | _     | 0       |
| XCORB     | Asymmetry term of non-universality factor                                      | _     | 1       |
| XCORBO    | Asymmetry term of non-universality factor                                      | _     | 1       |
| XCORL     | Length dependence of XCOR  | _     | 0       |
| XCORLEXP  | Exponent describing length dependence of XCOR                                  | _     | 1       |
| XCORLW    | Area dependence of XCOR  | _     | 0       |
| XCORO     | Geometry-independent part of non-universality factor                           | _     | 0       |
| XCORW     | Width dependence of XCOR   | _     | 0       |
| XGE       | Fraction of Ge content in the channel  | _     | 0       |
| XGEO      | Fraction of Ge content in the channel  | _     | 0       |

Table 2-142. MOSFET level 10240 Output Variables

| Parameter  | Description  | Units | Default |
|------------|--|-------|---------|
| type       | Flag for channel type  |       | none    |
| vds        | Internal drain-source DC voltage (NMOS convention)                                     | V     | none    |
| vsb        | Internal source-bulk DC voltage (NMOS convention)                                      | V     | none    |
| vgs        | Internal gate-source DC voltage (NMOS convention)                                      | V     | none    |
| vth        | Threshold voltage  | V     | none    |
| vth_drive  | Effective gate drive voltage, including back bias, drain bias effects and self-heating | V     | none    |
| vdsat      | Drain saturation voltage at the given bias   | V     | none    |
| vdsat_marg | Vds voltage margin   | V     | none    |

Table 2-142. MOSFET level 10240 Output Variables

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| id        | Total DC drain current flowing into drain terminal                       | A     | none    |
| ig        | Total DC gate current flowing into gate terminal                         | A     | none    |
| is        | Total DC source current flowing into source terminal                     | A     | none    |
| ib        | Total DC bulk current flowing into bulk terminal                         | A     | none    |
| ids       | DC channel current, excluding tunnel, GISL and GIDL currents             | A     | none    |
| igidl     | DC Gate Induced Drain Leakage current                                    | A     | none    |
| igisl     | DC Gate Induced Source Leakage current                                   | A     | none    |
| igs       | DC gate-source leakage current   | A     | none    |
| igd       | DC gate-drain leakage current  | A     | none    |
| idb       | DC drain-bulk current  | A     | none    |
| isb       | DC source-bulk current   | A     | none    |
| gm        | Internal DC transconductance   | A/V   | none    |
| gmb       | Internal DC bulk transconductance  | A/V   | none    |
| gds       | Internal DC output conductance   | A/V   | none    |
| cgg       | Internal AC gate capacitance, including overlap capacitances             | F     | none    |
| cgd       | Internal AC gate-drain transcapacitance, including overlap capacitances  | F     | none    |
| cgs       | Internal AC gate-source transcapacitance, including overlap capacitances | F     | none    |
| cgb       | Internal AC gate-bulk transcapacitance                                   | F     | none    |
| cdd       | Internal AC drain capacitance  | F     | none    |
| cdg       | Internal AC drain-gate transcapacitance                                  | F     | none    |
| cds       | Internal AC drain-source transcapacitance                                | F     | none    |
| cdb       | Internal AC drain-bulk transcapacitance                                  | F     | none    |
| cbb       | Internal AC bulk capacitance   | F     | none    |
| cbg       | Internal AC bulk-gate transcapacitance                                   | F     | none    |
| cbs       | Internal AC bulk-source transcapacitance                                 | F     | none    |
| cbd       | Internal AC bulk-drain transcapacitance                                  | F     | none    |
| CSS       | Internal AC source capacitance   | F     | none    |
| csg       | Internal AC source-gate transcapacitance                                 | F     | none    |
| csb       | Internal AC source-bulk transcapacitance                                 | F     | none    |
| csd       | Internal AC source-drain transcapacitance                                | F     | none    |
| tk        | MOSFET device temperature  | K     | none    |
| dtsh      | MOSFET device temperature increase due to self-heating                   | K     | none    |

Table 2-142. MOSFET level 10240 Output Variables

| Parameter | Description                                      | Units            | Default |
|-----------|--|------------------|---------|
| self_gain | Internal L-UTSOI model self gain                 |                  | none    |
| rout      | AC output resistance                             | Ohm              | none    |
| beff      | Gain factor in saturation                        | A/V <sup>2</sup> | none    |
| ft        | Unity gain frequency at the given bias           | Hz               | none    |
| rgate     | MOS gate resistance (intrinsic input resistance) | Ohm              | none    |
| gmoverid  | Gm over Id                                       | 1/V              | none    |
| vearly    | Equivalent Early voltage                         | V                | none    |

Due to licensing restrictions, the  $L\_UTSOI$  MOSFET is not available in open-source versions of Xyce. The license for  $L\_UTSOI$  authorizes Sandia National Laboratories to distribute this model only in binary versions of code at this time.

# 2.3.21. Lossy Transmission Line (LTRA)

## **Symbol**



# **Instance Form**

O<name> <A port (+) node> <A port (-) node>
+ <B port (+) node> <B port (-) node> [model name]

## **Model Form**

.MODEL <model name> LTRA R=<value> L=<value> C=<value>
+ G=<value> LEN=<value> [model parameters]

# **Examples**

Oline1 inp inn outp outn cable1 Oline2 inp inn outp outn cable1

#### **Comments**

The lossy transmission line, or LTRA, device is a two port (A and B), bi-directional device. The (+) and (-) nodes define the polarity of a positive voltage at a port.

R, L, C, and G are the resistance, inductance, capacitance, and conductance of the transmission line per unit length, respectively. LEN is the total length of the transmission line. Supported configurations for the LTRA are RLC, RC, LC (lossless) and RG.

The lossy transmission line, or LTRA, device does not work with AC analysis at this time. LTRA models will need to be replaced with lumped transmission line models (YTRANSLINE) when used in AC analysis. The LTRA models do work correctly in harmonic balance simulation.

**Table 2-143. Lossy Transmission Line Device Model Parameters** 

| Parameter          | Description  | Units                         | Default |
|--------------------|--|-------------------------------|---------|
| ABS                | Abs. rate of change of deriv. for bkpt                               | _                             | 1       |
| С                  | Capacitance per unit length  | F/m                           | 0       |
| COMPACTABS         | special abstol for straight line checking                            | _                             | 1e-12   |
| COMPACTREL         | special reltol for straight line checking                            | _                             | 0.001   |
| COMPLEXSTEPCONTROL | do complex time step control using local truncation error estimation | logical<br>(T/F)              | false   |
| G                  | Conductance per unit length  | $\Omega^{-1}$ m <sup>-1</sup> | 0       |
| L                  | Inductance per unit length   | $\mathrm{Hm}^{-1}$            | 0       |
| LEN                | length of line   | m                             | 0       |
| LININTERP          | use linear interpolation   | logical<br>(T/F)              | false   |

Table 2-143. Lossy Transmission Line Device Model Parameters

| Parameter    | Description  | Units            | Default |
|--------------|--|------------------|---------|
| MIXEDINTERP  | use linear interpolation if quadratic results look unacceptable      | logical<br>(T/F) | false   |
| NOSTEPLIMIT  | don't limit timestep size based on the time constant of the line     | logical<br>(T/F) | false   |
| QUADINTERP   | use quadratic interpolation  | logical<br>(T/F) | true    |
| R            | Resistance per unit length   | $\Omega/m$       | 0       |
| REL          | Rel. rate of change of deriv. for bkpt                               | _                | 1       |
| STEPLIMIT    | limit timestep size based on the time constant of the line           | logical<br>(T/F) | true    |
| TRUNCDONTCUT | don't limit timestep to keep impulse response calculation errors low | logical<br>(T/F) | false   |
| TRUNCNR      | use N-R iterations for step calculation in LTRAtrunc                 | logical<br>(T/F) | false   |

**Model Parameters** By default time step limiting is on in the LTRA. This means that simulation step sizes will be reduced if required by the LTRA to preserve accuracy. This can be disabled by setting NOSTEPLIMIT=1 and TRUNCDONTCUT=1 on the .MODEL line.

The option most worth experimenting with for increasing the speed of simulation is REL. The default value of 1 is usually safe from the point of view of accuracy but occasionally increases computation time. A value greater than 2 eliminates all breakpoints and may be worth trying depending on the nature of the rest of the circuit, keeping in mind that it might not be safe from the viewpoint of accuracy. Breakpoints may be entirely eliminated if the circuit does not exhibit any sharp discontinuities. Values between 0 and 1 are usually not required but may be used for setting many breakpoints.

COMPACTREL and COMPACTABS are tolerances that control when the device should attempt to compact past history. This can significantly speed up the simulation, and reduce memory usage, but can negatively impact accuracy and in some cases may cause problems with the nonlinear solver. In general this capability should be used with linear type signals, such as square-wave-like voltages. In order to activate this capability the general device option TRYTOCOMPACT=1 must be set, if it is not no history compaction will be performed and the COMPACT options will be ignored.

#### Example:

.OPTIONS DEVICE TRYTOCOMPACT=1

**References** See references [34] and [35] for more information about the model.

# 2.3.22. Voltage- or Current-controlled Switch

#### **Instance Form**

```
S<name> <(+) switch node> <(-) switch node>
+ <(+) control node> <(-) control node>
+ <model name> [ON] [OFF]

W<name> <(+) switch node> <(-) switch node>
+ <control node voltage source>
```

# Model Form

```
.MODEL <model name> VSWITCH [model parameters]
.MODEL <model name> ISWITCH [model parameters]
```

#### **Examples**

```
S1 21 23 12 10 SMOD1
SSET 15 10 1 13 SRELAY
W1 1 2 VCLOCK SWITCHMOD1
W2 3 0 VRAMP SM1 ON
```

+ <model name> [ON] [OFF]

#### Comments

The voltage- or current-controlled switch is a particular type of controlled resistor. This model is designed to help reduce numerical issues. See Special Considerations below.

The resistance between the < (+) switch node> and the < (-) switch node> is dependent on either the voltage between the < (+) control node> and the < (-) control node> or the current through the control node voltage source. The resistance changes in a continuous manner between the RON and ROFF model parameters.

No resistance is inserted between the control nodes. It is up to the user to make sure that these nodes are not floating.

Even though evaluating the switch model is computationally inexpensive, for transient analysis Xyce steps through the transition section using small time-steps in order to calculate the waveform accurately. Thus, a circuit with many switch transitions can result in lengthy run times.

The ON and OFF parameters are used to specify the initial state of the switch at the first step of the operating point calculation; this does not force the switch to be in that state, it only gives the operating point solver an initial state to work with. If it is known that the switch should be in a particular state in the operating point it could help convergence to specify one of these keywords.

The power dissipated in the switch is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . This will essentially be the power dissipated in either RON or ROFF, since the switch is a particular type of controlled resistor.

**Note:** The voltage- and current-controlled switches specified in this manner are converted at parse time into equivalent "generic" switches.

Table 2-144. Controlled Switch Device Model Parameters

| Parameter | Description       | Units | Default |
|-----------|-------------------|-------|---------|
| IOFF      | Off current       | A     | 0       |
| ION       | On current        | A     | 0.001   |
| OFF       | Off control value | _     | 0       |
| ON        | On control value  | _     | 1       |
| ROFF      | Off resistance    | Ω     | 1e+06   |
| RON       | On resistance     | Ω     | 1       |
| VOFF      | Off voltage       | V     | 0       |
| VON       | On voltage        | V     | 1       |

#### **Model Parameters**

# **Special Considerations**

- Due to numerical limitations, Xyce can only manage a dynamic range of approximately 12 decades. Thus, it is recommended the user limit the ratio **ROFF/RON** to less than 10<sup>12</sup>. This soft limitation is not enforced by the code, and larger ratios might converge for some problems.
- Do not set **RON** to 0.0, as the code computes the "on" conductance as the inverse of **RON**. Using 0.0 will cause the simulation to fail when this invalid division results in an infinite conductance. Use a very small, but non-zero, on resistance instead.
- Furthermore, it is a good idea to limit the narrowness of the transition region. This is because in the transition region, the switch has gain and the narrower the region, the higher the gain and the more potential for numerical problems. The smallest value recommended for  $\|\mathbf{VON} \mathbf{VOFF}\|$  or  $\|\mathbf{ION} \mathbf{IOFF}\|$  is  $1 \times 10^{-12}$ . This recommendation is not a restriction, and you might find for some problems that narrower transition regions might work well.

**Controlled switch equations** The equations in this section use the following variables:

 $R_s$  = switch resistance

 $V_c$  = voltage across control nodes

 $I_c$  = current through control node voltage source

 $L_m = \text{log-mean of resistor values}$   $= \ln \left( \sqrt{\text{RON} \cdot \text{ROFF}} \right)$   $L_r = \text{log - ratio of resistor values}$   $= \ln \left( \text{RON} / \text{ROFF} \right)$   $V_d = \text{difference of control voltages}$  = VON - VOFF  $I_d = \text{difference of control currents}$  = ION - IOFF

**Switch Resistance** To compute the switch resistance, Xyce first calculates the "switch state" S as  $S = (V_c - \mathbf{VOFF})/V_d$  or  $S = (I_c - \mathbf{IOFF})/I_d$ . The switch resistance is then:

$$R_{s} = \begin{cases} & \textbf{RON}, & S \ge 1.0 \\ & \textbf{ROFF}, & S \le 0.0 \\ & \exp\left(L_{m} + 0.75L_{r}(2S - 1) - 0.25L_{r}(2S - 1)^{3}\right), & 0 < S < 1 \end{cases}$$

## 2.3.23. Generic Switch

| Instance Form | <pre>S<name> &lt;(+) switch node&gt; &lt;(-) switch node&gt; <model name=""> [ON] [OFF] <control =="" expression=""></control></model></name></pre>                          |
|---------------|--|
| Model Form    | .MODEL <model name=""> VSWITCH [model parameters] .MODEL <model name=""> ISWITCH [model parameters] .MODEL <model name=""> SWITCH [model parameters]</model></model></model> |
| Examples      | <pre>S1 1 2 SWI OFF CONTROL={I(VMON)} SW2 1 2 SWV OFF CONTROL={V(3)-V(4)} S3 1 2 SW OFF CONTROL={if(time&gt;0.001,1,0)}</pre>  |

#### **Comments**

The generic switch is similar to the voltage- or current-controlled switch except that the control variable is anything that can be writen as an expression. The examples show how a voltage- or current-controlled switch can be implemented with the generic switch. Also shown is a relay that turns on when a certain time is reached. Model parameters are given in Table 2-144.

The voltage- and current-controlled switch syntaxes are converted at parse time to their equivalent generic device, and so all three variants in fact use the same code internally.

The power dissipated in the generic switch is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ . This will essentially be the power dissipated in either RON or ROFF, since the generic switch is a particular type of controlled resistor.

## 2.3.24. Linear device

The linear (YLIN) device allows an S-, Y-, or Z-parameter model to be used to define an N-port device. It is mostly commonly used as part of a Harmonic Balance (HB) analysis.

| <b>Instance Form</b>      | YLIN <name> &lt;(+) node&gt; &lt;(-) node&gt; [model name]</name>                      |
|---------------------------|--|
| Model Form                | .MODEL <model name=""> LIN [model parameters]</model>                                  |
| Examples                  | YLIN YLIN1 1 0 2 0 YLIN_MOD1 .MODEL YLIN_MOD1 LIN TSTONEFILE=yparams.y2p               |
| Parameters and<br>Options | model name  Name of the model defined in a .MODEL line.                                |
| Comments                  | At present, the YLIN device is only supported in the frequency domain for HB analyses. |

**Table 2-145. LIN Device Model Parameters** 

| Parameter  | Description  | Units            | Default |
|------------|--|------------------|---------|
| ISC_FD     | Touchstone file contains frequency-domain short-circuit current data | logical<br>(T/F) | false   |
| TSTONEFILE | Touchstone File Name   | _                | "       |

**Model Parameters** The Touchstone file name must be specified. The YLIN device accepts both Touchstone 1 and Touchstone 2 formatted input files [7].

For coupling with EM codes, such as EIGER, the YLIN device also accepts a non-standard version of the Touchstone input files. If the <code>ISC\_FD</code> model parameter is set to true then each row of "network data" in the input file also contains additional columns with the "per-port frequency-domain short-circuit currents". There are then two such additional columns for each port. The format (RI, MA or DB) of those additional columns will be as specified by the Option line in the Touchstone file. In this non-standard case, only the "Full" matrix format is supported for Touchstone 2 input files.

# 2.3.25. Lossless (Ideal) Transmission Line

## **Symbol**



# **Instance Form**

```
T<name> <port 1 (+) node> <port 1 (-) node>
+ <port 2 (+) node> <port 2 (-) node>
+ Z0=<value> [TD=<value>] [F=<value> [NL=<value>]]
```

## **Examples**

```
Tline inp inn outp outn Z0=50 TD=1us
Tline2 inp inn outp outn Z0=50 F=1meg NL=1.0
```

#### **Comments**

The lossless transmission line device is a two port (A and B), bi-directional delay line. The (+) and (-) nodes define the polarity of a positive voltage at a port.

Z0 is the characteristic impedance. For user convenience, Z0 ("Zee Oh") is an allowed synonym for Z0 ("Zee Zero").

The transmission line's length is specified by either TD (a delay in seconds) or by the combination of F and NL (a frequency in Hz and the relative wavelength at F). NL defaults to 0.25 (F is the quarter-wave frequency). If F is given, the time delay is computed as  $\frac{NL}{E}$ .

While both TD and F are optional, at least one of them must be given. It is an instance line error if both are given.

Lead currents for the two terminals (1 and 2) of the lossless transmission device (e.g.,for the T device line2) are accessed via I1(Tline2) and I2(Tline2). The polarity conventions are that positive current flows into the positive node of the specified terminal, and negative current flows out of the positive node of the specified terminal.

Power for the lossless transmission line is calculated as  $I_1 \cdot \Delta V_1 + I_2 \cdot \Delta V_2$ , where the voltage drops ( $\Delta V_1$  and  $\Delta V_2$ ) are the voltage drops between the positive and negative terminals of each port (e.g.,  $\Delta V = (V_+ - V_-)$ ). The sign conventions for the lead currents  $I_1$  and  $I_2$  were given in the previous paragraph. This definition can be viewed as the instantaneous sum of the power flowing into terminal 1 and the power flowing into terminal 2. This definition for power for the lossless transmission line may differ from commercial simulators, such as HSPICE.

The lossless transmission line device does not work with AC analysis at this time. Lossless transmission line models will need to be replaced with lumped transmission line models (YTRANSLINE) when used in AC analysis. The lossless transmission line does work correctly in harmonic balance simulation.

**Table 2-146. Ideal Transmission Line Device Instance Parameters** 

| Parameter | Description              | Units | Default |
|-----------|--------------------------|-------|---------|
| F         | Frequency                | Hz    | 0       |
| NL        | Length in wavelengths    | _     | 0.25    |
| TD        | Time delay               | S     | 0       |
| Z 0       | Characteristic Impedance | Ω     | 0       |
| ZO        | Characteristic Impedance | Ω     | 0       |

# **Instance Parameters**

# 2.3.26. Lumped Transmission Line

## Symbol



#### **Instance Form**

ytransline <name> <Input port> <Output port> testLine
+ len=<value> lumps=<value>

#### **Model Form**

.model testLine transline r=<value> l=<value>
+ c=<value> [model parameters]

## **Examples**

ytransline line1 inn out testLine len=12.0 lumps=1440

#### **Comments**

The lumped transmission line, device is a two port bi-directional device. The specification is patterned, loosely, from the netlist specification for the LTRA device.

R, L, and C are the resistance, inductance, and capacitance of the transmission line per unit length, respectively. LEN is the total length of the transmission line, and LUMPS is the number of lumped elements used to discretize the line. Supported configurations for this device are RLC and LC.

Unlike the LTRA device, which is based on an analytic solution, this device is based on assembling chains of linear R,L and C devices to approximate the solution to the Telegraph equations. It is the functional equivalent of building a transmission line in the netlist using subcircuits of linear elements. The advantage of using this approach is that it automates the mechanics of this process, and thus is less prone to error. It can be used with all analysis types, including harmonic balance (HB).

The model is based on the assumption that the segments of the line are evenly spaced. The number of segments is specified by the parameter LUMPS and the larger this number, the more accurate the calculation.

Table 2-147. Lumped Transmission Line Device Instance Parameters

| Parameter | Description    | Units | Default |
|-----------|----------------|-------|---------|
| LEN       | length of line | m     | 0       |
| LUMPS     |                | _     | 1       |

#### **Device Parameters**

**Table 2-148. Lumped Transmission Line Device Model Parameters** 

| Parameter | Description                 | Units  | Default |
|-----------|-----------------------------|--|---------|
| С         | Capacitance per unit length | F/m  | 0       |
| ELEV      |                             | _  | 2       |
| G         | Conductance per unit length | $\begin{array}{c} \Omega^{-1} \\ m^{-1} \end{array}$ | 0       |
| L         | Inductance per unit length  | $\mathrm{Hm}^{-1}$                                   | 0       |
| R         | Resistance per unit length  | $\Omega/m$   | 0       |

# **Model Parameters**

# 2.3.27. Ideal Delay

An ideal delay device, operating in a manner similar to a voltage-controlled voltage source, is provided by the YDELAY device.

#### **Instance Form**

```
YDELAY <name> <positive node> <negative node>
```

- + <positive control node> <negative control node>
- + TD=<time delay>
- + [EXTRAPOLATION=<true|false>] [BPENABLED=<true|false>]
- + [LINEARINTERP=<true|false>]

# **Examples**

```
YDELAY delay1 2 0 1 0 TD=10N
R1 2 0 1
YDELAY delay1 3 0 2 0 TD=10N LINEARINTERP=true
R2 3 0 1
YDELAY delay1 4 0 3 0 TD=10N BPENABLED=FALSE
R4 4 0 1
YDELAY delay1 5 0 4 0 TD=10N EXTRAPOLATION=false
R5 5 0 1
```

#### **Comments**

The voltage between the positive and negative control nodes is reproduced at the positive and negative output nodes delayed by a time equal to the specified TD parameter.

The device is equivalent in connectivity to a voltage-controlled voltage source — the device puts no load on the control nodes, and its output must be connected to a valid circuit.

Unlike the transmission line, no impedance matching is required, and reflections due to impedance mismatch do not occur.

These devices may be chained to create outputs at different delays, but each instance must have its output connected to a valid closed circuit. The examples above are chained correctly so that each of the output nodes is delayed by 10 nanoseconds from the previous stage.

The device functions by storing a history of its input at each accepted time point. At each new time step, interpolation is performed on this history to determine what the signal would have been at a time TD in the past. At each step, the device checks its history to determine if the previous three saved steps include a discontinuity in the input. If so, the device assures that Xyce will correctly resolve the same discontinuity when it appears on the output.

With no special options specified, three-point quadratic interpolation is used except after a discontinuity, when linear interpolation is performed. If Xyce has advanced the time by more than TD and no discontinuity has occured, then this interpolation is actually extrapolation.

When LINEARINTERP=true is specified, the history interpolation used is always linear interpolation.

When EXTRAPOLATION=false, Xyce will never attempt extrapolation when it has taken a time step larger than TD. In this case, the current, unconverged value of the solution is used as the third interpolation point and the interpolation is recomputed at every step of the nonlinear solve.

When BPENABLED=false, the device will not set a simulation breakpoint to force the time integrator to stop exactly TD seconds after a detected discontinuity on the input. It will still force a maximum time step on the time integrator after such a discontinuity, and other techniques will be applied to assure the discontinuity is resolved. This option may result in Xyce rejecting a lot more time steps and slower simulation than when it is left at its default.

# 2.3.27.1. Delay device instance parameters

The instance parameters for the delay device are shown in Table 2-149.

**Table 2-149. Delay element Device Instance Parameters** 

| Parameter     | Description  | Units | Default |
|---------------|--|-------|---------|
| BPENABLED     | Can this device set discontinuity breakpoints?               | -     | true    |
| EXTRAPOLATION | Can this device use extrapolation on history?                | -     | true    |
| LINEARINTERP  | Should this device use only linear interpolation on history? | _     | false   |
| TD            | Time delay   | S     | 0       |

#### 2.3.28. Behavioral Digital Devices

# **Instance Form** U<name> <type>(<num inputs>) [digital power node] + [digital ground node] <input node>\* <output node>\* + <model name> [device parameters] **Model Form** .MODEL <model name> DIG [model parameters] **Examples** UMYAND AND(2) DPWR DGND in1 in2 out DMOD IC=TRUE UTHEINV INV DPWR DGND in out DMOD .model DMOD DIG ( + CLO=1e-12 CHI=1e-12 + SORLO=5 SORHI=5 SOTSW=5e-9 + S0VLO=-1 S0VHI=1.8 + S1RLO=200 S1RHI=5 S1TSW=5e-9 + S1VLO=1 S1VHI=3 + RLOAD=1000 + CLOAD=1e-12

# Parameters and **Options**

## type

+ DELAY=20ns )

Type of digital device. Supported devices are: INV, BUF, AND, NAND, OR, NOR, XOR, NXOR, DFF, JKFF, TFF, DLTCH and ADD. (Note: NOT is an allowed synonym for INV, but will be deprecated in future Xyce releases.) The following gates have a fixed number of inputs. INV and BUF have only one input and one output node. XOR and NXOR have two inputs and one output. ADD has three inputs (in1, in2, carryIn) and two outputs (sumOut and carryOut). DFF has four inputs (PREB, CLRB, Clock and Data) and two outputs (Q and  $\bar{Q}$ ). TFF has two inputs (T and CLK) and two outputs (Q and  $\bar{Q}$ ). The TFF uses "positive" ("rising") edge clocking. The JKFF has five inputs (PREB, CLRB, Clock, J and K) and two outputs (Q and  $\bar{Q}$ ). The JKFF uses "negative" ("falling") edge clocking. DLTCH has four inputs (PREB, CLRB, Enable and Data) and two outputs (Q and  $\bar{Q}$ ). The AND, NAND, OR and NOR gates have one output but a variable number of inputs. There is no limit on the number of inputs for AND,

NAND, OR and NOR gates, but there must be at least two inputs.

## num inputs

For AND, NAND, OR and NOR gates, with N inputs, the syntax is (N), as shown for the MYAND example given above, where AND(2) is specified. The inclusion of (N) is mandatory for gates with a variable number of inputs, and both the left and right parentheses must be used to enclose N. This parameter is optional, and typically omitted, for gates with a fixed number of inputs, such as INV, BUF, XOR, NXOR, DFF, JKFF, TFF,

DLTCH and ADD. This is illustrated by the THEINV example given above, where the device type is INV rather than INV(1).

## digital power node

Dominant node to be connected to the output node(s) to establish high output state. This node is connected to the output by a resistor and capacitor in parallel, whose values are set by the model. This node must be specified on the instance line.

## digital ground node

This node serves two purposes, and must be specified on the instance line. It is the dominant node to be connected to the output node(s) to establish low output state. This node is connected to the output by a resistor and capacitor in parallel, whose values are set by the model. This node is also connected to the input node by a resistor and capacitor in parallel, whose values are set by the model. Determination of the input state is based on the voltage drop between the input node and this node.

#### input nodes, output nodes

Input and output nodes that connect to the circuit.

#### model name

Name of the model defined in a .MODEL line.

#### device parameters

Parameter listed in Table 2-150 may be provided as

<parameter>=<value> specifications as needed. For devices with more
than one output, multiple output initial states may be provided as Boolean
values in either a comma separated list (e.g. IC=TRUE,FALSE for a device
with two outputs) or individually (e.g. IC1=TRUE IC2=FALSE or
IC2=FALSE). Finally, the IC specification must use TRUE and FALSE
rather than T and F.

**Table 2-150. Behavioral Digital Device Instance Parameters** 

| Parameter | Description                            | Units            | Default |
|-----------|--|------------------|---------|
| IC1       | Vector of initial values for output(s) | logical<br>(T/F) | false   |
| IC2       |  | _                | false   |

#### **Device Parameters**

Table 2-151. Behavioral Digital Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| CHI       | Capacitance between output node and high reference | F     | 1e-06   |
| CLO       | Capacitance between output node and low reference  | F     | 1e-06   |
| CLOAD     | Capacitance between input node and input reference | F     | 1e-06   |

Table 2-151. Behavioral Digital Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DELAY     | Delay time of device   | S     | 1e-08   |
| RLOAD     | Resistance between input node and input reference            | Ω     | 1000    |
| SORHI     | Low state resitance between output node and high reference   | Ω     | 100     |
| SORLO     | Low state resistance between output node and low reference   | Ω     | 100     |
| SOTSW     | Switching time transition to low state                       | S     | 1e-08   |
| SOVHI     | Maximum voltage to switch to low state                       | V     | 1.7     |
| SOVLO     | Minimum voltage to switch to low state                       | V     | -1.5    |
| S1RHI     | High state resistance between output node and high reference | Ω     | 100     |
| S1RLO     | High state resistance between output node and low reference  | Ω     | 100     |
| S1TSW     | Switching time transition to high state                      | S     | 1e-08   |
| S1VHI     | Maximum voltage to switch to high state                      | V     | 7       |
| S1VLO     | Minimum voltage to switch to high state                      | V     | 0.9     |

#### **Model Parameters**

**Model Description** The input interface model consists of the input node connected with a resistor and capacitor in parallel to the digital ground node. The values of these are: **RLOAD** and **CLOAD**.

The logical state of any input node is determined by comparing the voltage relative to the reference to the range for the low and high state. The range for the low state is **S0VLO** to **S0VHI**. Similarly, the range for the high state is **S1VLO** to **S1VHI**. The state of an input node will remain fixed as long as its voltage stays within the range for its current state. That input node will transition to the other state only when its state goes outside the voltage range of its current state.

The output interface model is more complex than the input model, but shares the same basic configuration of a resistor and capacitor in parallel to simulate loading. For the output case, there are such parallel RC connections to two nodes, the digital ground node and the digital power node. Both of these nodes must be specified on the instance line.

The capacitance to the high node is specified by **CHI**, and the capacitance to the low node is **CLO**. The resistors in parallel with these capacitors are variable, and have values that depend on the state. In the low state (S0), the resistance values are: **S0RLO** and **S0RHI**. In the high state (S1), the resistance values are: **S1RLO** and **S1RHI**. Transition to the high state occurs exponentially over a time of **S1TSW**, and to the low state **S0TSW**.

The device's delay is given by the model parameter **DELAY**. Any input changes that affect the device's outputs are propagated after this delay.

As a note, the model parameters **VREF**, **VLO** and **VHI** are used by the now deprecated Y-type digital device, but are ignored by the U device. A warning message is emitted if any of these three parameters are used in the model card for a U device.

Another caveat is that closely spaced input transitions to the Xyce digital behavioral models may not be accurately reflected in the output states. In particular, input-state changes spaced by more than DELAY seconds have independent effects on the output states. However, two input-state changes (S1 and S2) that occur within DELAY seconds (e.g., at time=t1 and time=t1+0.5\*DELAY) have the effect of masking the effects of S1 on the device's output states, and only the effects of S2 are propagated to the device's output states.

**DCOP Calculations for Flip-Flops and Latches** The behavior of the digital devices during the DC Operating Point (DCOP) calculations can be controlled via the IC1 and IC2 instance parameters and the DIGINITSTATE device option. See 2.1.25 for more details on the syntax for device options. Also, this section applies to the Y-Type Behavioral Digital Devices discussed in 2.3.29.

The IC1 instance parameter is supported for all gate types. The IC2 instance parameter is supported for all gate types that have two outputs. These instance parameters allow the outputs of individual gates to be set to known states (either TRUE (1) or FALSE (0)) during the DCOP calculation, irregardless of their input state(s). There are two caveats. First, the IC1 and IC2 settings at a given gate will override the global effects of the DIGINITSTATE option, discussed below, at that gate. Second, IC1 and IC2 do not support the X, or "undetermined", state discussed below.

The DIGINITSTATE option only applies to the DLTCH, DFF, JKFF and TFF devices. It was added for improved compatibility with PSpice. It sets the initial state of all flip-flops and latches in the circuit: 0=clear, 1=set, 2=X. At present, the use of the DIGINITSTATE option during the DCOP is the only place that Xyce supports the X, or "undetermined", state. The X state is modeled in Xyce by having the DLTCH, DFF, JKFF and TFF outputs simultaneously "pulled-up" and "pulled-down". That approach typically produces an output level, for the X state, that is approximately halfway between the voltage levels for TRUE and FALSE (e.g., halfway between V\_HI and V\_LO). As mentioned above, the IC1 and IC2 instance parameters take precedence at a given gate.

Xyce also supports a default DIGINITSTATE, whose value is 3. For this default value, for the DFF, JKFF, TFF and DLTCH devices, Xyce enforces Q and  $\bar{Q}$  being different at DCOP, if both PREB and CLRB are TRUE. The behavior of the DFF, JKFF and DLTCH devices at the DCOP for DIGINITSTATE=3 is shown in Tables 2-152, 2-154 and 2-153. In these three tables, the X state denotes the "Don't Care" condition, where the input state can be 0, 1 or the "undetermined" state. The first row in each truth-table (annotated with \*) is "unstable", and will change to a state with Q and  $\bar{Q}$  being different once both PREB and CLRB are not both in the FALSE state.

The behavior of the TFF device at the DCOP, for the default DIGINITSTATE of 3, is simpler, and is not shown as a table. The design decision was to have Q and  $\bar{Q}$  be different, with the Q value equal to the state of the T input.

Table 2-152. DFF Truth-Table for DIGINITSTATE=3

| PREB | CLRB | CLOCK | DATA | Q  | Q (Qbar) |
|------|------|-------|------|----|----------|
| 0    | 0    | X     | X    | 1* | 1*       |
| 0    | 1    | X     | X    | 1  | 0        |

Table 2-152. DFF Truth-Table for DIGINITSTATE=3

| PREB | CLRB | CLOCK | DATA | Q | $ar{\mathcal{Q}}$ ( <b>Qbar</b> ) |
|------|------|-------|------|---|-----------------------------------|
| 1    | 0    | X     | X    | 0 | 1                                 |
| 1    | 1    | X     | 0    | 0 | 1                                 |
| 1    | 1    | X     | 1    | 1 | 0                                 |

# Table 2-153. DLTCH Truth-Table for DIGINITSTATE=3

| PREB | CLRB | ENABLE | DATA | Q  | $ar{\mathcal{Q}}\left(\mathbf{Q}\mathbf{bar} ight)$ |
|------|------|--------|------|----|---|
| 0    | 0    | X      | X    | 1* | 1*  |
| 0    | 1    | X      | X    | 1  | 0   |
| 1    | 0    | X      | X    | 0  | 1   |
| 1    | 1    | X      | 0    | 0  | 1   |
| 1    | 1    | X      | 1    | 1  | 0   |

Table 2-154. JKFF Truth-Table for DIGINITSTATE=3

| PREB | CLRB | CLOCK | J | K | Q  | $ar{Q}$ ( <b>Q</b> bar) |
|------|------|-------|---|---|----|-------------------------|
| 0    | 0    | X     | X | X | 1* | 1*                      |
| 0    | 1    | X     | X | X | 1  | 0                       |
| 1    | 0    | X     | X | X | 0  | 1                       |
| 1    | 1    | X     | 0 | X | 0  | 1                       |
| 1    | 1    | X     | 1 | X | 1  | 0                       |

# 2.3.29. Y-Type Behavioral Digital Devices (Deprecated)

# **Instance Form** Y<type> <name> [low output node] [high output node] + [input reference node] <input node>\* <output node>\* <model name> [device parameters] **Model Form** .MODEL <model name> DIG [model parameters] **Examples** YAND MYAND in1 in2 out DMOD IC=TRUE YNOT THENOT in out DMOD YNOR ANOR2 vlo vhi vref in1 in2 out DDEF .model DMOD DIG ( + CLO=1e-12 CHI=1e-12 + SORLO=5 SORHI=5 SOTSW=5e-9 + S0VLO=-1 S0VHI=1.8 + S1RLO=200 S1RHI=5 S1TSW=5e-9 + S1VLO=1 S1VHI=3 + RLOAD=1000 + CLOAD=1e-12+ VREF=0 VLO=0 VHI=3 + DELAY=20ns ) .MODEL DDEF DIG

# Parameters and Options

#### type

Type of digital device. Supported devices are: NOT, BUF, AND, NAND, OR, NOR, XOR, NXOR, DFF, JKFF, TFF, DLTCH and ADD. (Note: INV is now the preferred synonym for NOT. The NOT device type will be deprecated in future Xyce releases.) For Y-type digital devices, all devices have two input nodes and one output node, except for NOT, DFF and ADD. NOT has one input and one output. ADD has three inputs (in1, in2, carryIn) and two outputs (sumOut and carryOut). DFF has four inputs (PREB, CLRB, Clock and Data) and two outputs (Q and Q). TFF has two inputs (Q and Clock) and two outputs (Q and Q). The TFF uses "positive" ("rising") edge clocking. The JKFF has five inputs (PREB, CLRB, Clock, J and K) and two outputs (Q and Q). The JKFF uses "negative" ("falling") edge clocking. DLTCH has four inputs (PREB, CLRB, Enable and Data) and two outputs (Q and Q).

#### name

Name of the device instance. This must be present, and when combined with the Y<type>, must be unique in the netlist. In the examples, MYAND, THENOT and ANOR2 have been used as names for the three devices.

#### low output node

Dominant node to be connected to the output node(s) to establish low output state. This node is connected to the output by a resistor and capacitor in

parallel, whose values are set by the model. If specified by the model, this node must be omitted from the instance line and a fixed voltage **VLO** is used instead.

#### high output node

Dominant node to be connected to the output node(s) to establish high output state. This node is connected to the output by a resistor and capacitor in parallel, whose values are set by the model. If specified by the model, this node must be omitted from the instance line and a fixed voltage **VHI** is used instead.

## input reference node

This node is connected to the input node by a resistor and capacitor in parallel, whose values are set by the model. Determination if the input state is based on the voltge drop between the input node and this node. If specified by the model, this node must be omitted from the instance line and a fixed voltage **VREF** is used instead.

## input nodes, output nodes

Nodes that connect to the circuit.

#### model name

Name of the model defined in a .MODEL line.

#### device parameters

Parameter listed in Table 2-155 may be provided as

<parameter>=<value> specifications as needed. For devices with more
than one output, multiple output initial states may be provided as Boolean
values in either a comma separated list (e.g. IC=TRUE,FALSE for a device
with two outputs) or individually (e.g. IC1=TRUE IC2=FALSE or
IC2=FALSE). Finally, the IC specification must use TRUE and FALSE
rather than T and F.

Table 2-155. Behavioral Digital Device Instance Parameters

| Parameter | Description                            | Units            | Default |
|-----------|--|------------------|---------|
| IC1       | Vector of initial values for output(s) | logical<br>(T/F) | false   |
| IC2       |  | _                | false   |

#### **Device Parameters**

Table 2-156. Behavioral Digital Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| CHI       | Capacitance between output node and high reference | F     | 1e-06   |
| CLO       | Capacitance between output node and low reference  | F     | 1e-06   |
| CLOAD     | Capacitance between input node and input reference | F     | 1e-06   |

Table 2-156. Behavioral Digital Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| DELAY     | Delay time of device   | S     | 1e-08   |
| RLOAD     | Resistance between input node and input reference            | Ω     | 1000    |
| SORHI     | Low state resitance between output node and high reference   | Ω     | 100     |
| SORLO     | Low state resistance between output node and low reference   | Ω     | 100     |
| SOTSW     | Switching time transition to low state                       | S     | 1e-08   |
| SOVHI     | Maximum voltage to switch to low state                       | V     | 1.7     |
| SOVLO     | Minimum voltage to switch to low state                       | V     | -1.5    |
| S1RHI     | High state resistance between output node and high reference | Ω     | 100     |
| S1RLO     | High state resistance between output node and low reference  | Ω     | 100     |
| S1TSW     | Switching time transition to high state                      | S     | 1e-08   |
| S1VHI     | Maximum voltage to switch to high state                      | V     | 7       |
| S1VLO     | Minimum voltage to switch to high state                      | V     | 0.9     |
| VHI       | Internal high state supply voltage                           | V     | 0       |
| VLO       | Internal low state supply voltage                            | V     | 0       |
| VREF      | Internal reference voltage for inputs                        | V     | 0       |

#### **Model Parameters**

**Model Description** The input interface model consists of the input node connected with a resistor and capacitor in parallel to the digital ground node. The values of these are: **RLOAD** and **CLOAD**.

The logical state of any input node is determined by comparing the voltage relative to the reference to the range for the low and high state. The range for the low state is **S0VLO** to **S0VHI**. Similarly, the range for the high state is **S1VLO** to **S1VHI**. The state of an input node will remain fixed as long as its voltage stays within the voltage range for its current state. That input node will transition to the other state only when its state goes outside the range of its current state.

The output interface model is more complex than the input model, but shares the same basic configuration of a resistor and capacitor in parallel to simulate loading. For the output case, there are such connections to two nodes, the digital ground node and the digital power node. Both of these nodes must be specified on the instance line.

The capacitance to the high node is specified by **CHI**, and the capacitance to the low node is **CLO**. The resistors in parallel with these capacitors are variable, and have values that depend on the state. In the low state (S0), the resistance values are: **S0RLO** and **S0RHI**. In the high state (S1), the resistance values are: **S1RLO** and **S1RHI**. Transition to the high state occurs exponentially over a time of **S1TSW**, and to the low state **S0TSW**.

The device's delay is given by the model parameter **DELAY**. Any input changes that affect the device's outputs are propagated after this delay.

Another caveat is that closely spaced input transitions to the Xyce digital behavioral models may not be accurately reflected in the output states. In particular, input-state changes spaced by more than DELAY seconds have independent effects on the output states. However, two input-state changes (S1 and S2) that occur within DELAY seconds (e.g., at time=t1 and time=t1+0.5\*DELAY) have the effect of masking the effects of S1 on the device's output states, and only the effects of S2 are propagated to the device's output states.

**DCOP Calculations for Flip-Flops and Latches** The behavior of the digital devices during the DC Operating Point (DCOP) calculations can be controlled via the IC1 and IC2 instance parameters and the DIGINITSTATE device option. See 2.3.28 and 2.1.25 for more details on these instance parameters and device option.

Converting Y-Type Digital Devices to U-Type Digital Devices 

Xyce is migrating the digital behavioral devices to U devices. The goal is increased compatibility with PSpice netlists. This subsection gives four examples of how to convert an existing Xyce netlist using Y-type digital devices to the corresponding U device syntaxes. The conversion process depends on whether the device has a fixed number of inputs or a variable number of inputs. In all cases, the model parameters VREF, VLO and VHI should be omitted from the U device model card. For U devices, the nodes vlo and vhi are always specified on the instance line.

Example 1: Fixed number of inputs, Y-device model card contains **VREF**, **VLO** and **VHI**. Assume **VREF=VLO**.

```
YNOT THENOT in out DMOD
.model DMOD DIG (
+ CLO=1e-12 CHI=1e-12
+ SORLO=5 SORHI=5 SOTSW=5e-9
+ S0VLO=-1 S0VHI=1.8
+ S1RLO=200 S1RHI=5 S1TSW=5e-9
+ S1VLO=1 S1VHI=3
+ RLOAD=1000
+ CLOAD=1e-12
+ VREF=0 VLO=0 VHI=3
+ DELAY=20ns )
* Digital power node. Assume digital ground node = GND
V1 DPWR 0 3V
UTHENOT INV DPWR 0 in out DMOD1
.model DMOD1 DIG (
+ CLO=1e-12 CHI=1e-12
+ SORLO=5 SORHI=5 SOTSW=5e-9
+ S0VLO=-1 S0VHI=1.8
+ S1RLO=200 S1RHI=5 S1TSW=5e-9
+ S1VLO=1 S1VHI=3
```

- + RLOAD=1000
- + CLOAD=1e-12
- + DELAY=20ns )

Example 2: Fixed number of inputs, Y-device instance line contains vlo, vhi and vref. Assume vref=vlo.

YNOT THENOT vlo vhi vref in out DMOD1 UTHENOT INV vhi vlo in out DMOD1

Example 3: Variable number of inputs, Y-device model card contains **VREF**, **VLO** and **VHI**. Assume **VREF=VLO**.

YAND MYAND in1 in2 out DMOD
UMYAND AND(2) DPWR 0 in1 in2 out DMOD1

Example 4: Variable number of inputs, Y-device instance line contains **vlo**, **vhi** and **vref**. Assume **vref=vlo**.

YAND MYAND vlo vhi vref in1 in2 out DMOD1 UMYAND AND(2) vhi vlo in1 in2 out DMOD1

#### 2.3.30. Accelerated mass

Simulation of electromechanical devices or magnetically driven machines may require that Xyce simulate the movement of an accelerated mass, that is, to solve the second order initial value problem

$$\frac{d^2x}{dt} = a(t)$$

$$x(0) = x_0$$

$$\dot{x}_0 = v_0$$

where x is the position of the object,  $\dot{x}$  its velocity, and a(t) the acceleration. In Xyce, this simulation capability is provided by the accelerated mass device.

#### **Instance Form**

```
YACC <name> <acceleration node> <velocity node> <position node>
+ [v0=<initial velocity>] [x0=<initial position>]
```

#### **Examples**

```
* Simulate a projectile thrown upward against gravity
V1 acc 0 -9.8
R1 acc 0 1
YACC acc1 acc vel pos v0=10 \times 0=0
.print tran v(pos)
.tran 1u 10s
.end
* Simulate a damped, forced harmonic oscillator
* assuming K, c, mass, amplitude and frequency
* are defined in .param statements
B1 acc 0 V=\{(-K * v(pos) - c*v(vel))/mass
+
             + amplitude*sin(frequency*TIME)}
R1 acc 0 1
YACC acc2 acc vel pos v0=0 x0=0.4
.print tran v(pos)
.tran 1u 10s
.end
```

#### **Comments**

When used as in the examples, Xyce will emit warning messages about the pos and vel nodes not having a DC path to ground. This is normal and should be ignored. The position and velocity nodes should not be connected to any real circuit elements. Their values may, however, be used in behavioral sources; this is done in the second example.

#### 2.3.31. Power Grid

The Power Grid devices are a family of device models that can be used to model steady-state power flow in electric power grids. They include device models for branches, bus shunts, transformers and generator buses.

Power flow in electric power grids can be modeled as a complex-valued voltage-current problem with standard admittance-matrix techinques. This approach solves the system of equations I = YV, and is termed IV format in this document. However, it is more typically modeled as a power-flow problem that solves the system of equations  $S = P + jQ = VI^*$ , where S is the complex power flow, V and I are complex-valued quantities, and  $I^*$  is the complex conjugate of I. The complex power flow can then be solved in either rectangular or polar coordinates. These two solution formats are termed PQ Rectangular (aka, PQR format) and PQ Polar (aka, PQP format) in this document. The variables for each solution format are described in more detail in the device descriptions given below.

In all three formulations, an Equivalent Real Formulation (ERF) [36] must be used for compatibility with the existing solver libraries in Xyce. More details on these equations are given below after the individual device descriptions.

#### **PowerGridBranch**

| <b>Instance Form</b> | Y <type> <name> <input node1=""/> <output node1=""></output></name></type>    |
|----------------------|---|
|                      | <pre>+ <input node2=""/> <output node2=""> [device parameters]</output></pre> |

#### **Examples**

YPOwerGridBranch pg1\_2 VR1 VR2 VI1 VI2 AT=IV R=0.05 B=0.1 X=0.05 YPGBR pg1\_2a VR1 VR2 VI1 VI2 AT=IV R=0.05 B=0.1 X=0.05 YPowerGridBranch pg1\_2b VR1 VR2 VI1 VI2 AT=PQR R=0.05 B=0.1 X=0.05 YPGBR pg1\_2c VR1 VR2 VI1 VI2 AT=PQR R=0.05 B=0.1 X=0.05 YPowerGridBranch pg1\_2d Th1 Th2 VM1 VM2 AT=PQP R=0.05 B=0.1 X=0.05 YPGBR pg1\_2e Th1 Th2 VM1 VM2 AT=PQP R=0.05 B=0.1 X=0.05

# Parameters and Options

#### type

The device type has a verbose (PowerBranchBranch) and a shortened (PGBR) form. Their usage may be mixed within a netlist.

#### name

Name of the device instance. This must be present, and unique amongst the PowerGridBranch devices in the netlist.

## input node

There are two input nodes, <input node1> and <input node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the Equivalent Real Form (ERF) described below in the equation subsections. For IV and PQR formats, <input node1> is the real part (VR) of the voltage at terminal 1 while <input node2> is the imaginary part (VI) of the voltage at terminal 1. For PQP format, <input node1> is

the angle ( $\Theta$  or Th) of the voltage at terminal 1 while <input node2> is the magnitude (VM or |V|) of the voltage at terminal 1. Finally, by analogy to other Xyce devices, node 1 can be considered as the positive terminal for this device, while node 2 is the negative terminal.

## output node

There are two output nodes, <output node1> and <output node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the ERF described below in the equation subsections. For IV and PQR formats, <output node1> is the real part (VR) of the voltage at terminal 2 while <output node2> is the imaginary part (VI) of the voltage at terminal 2. For PQP format, <output node1> is the angle ( $\Theta$  or Th) of the voltage at terminal 2 while <output node2> is the magnitude (VM or |V|) of the voltage at terminal 2. Finally, by analogy to other Xyce devices, node 2 can be considered as the negative terminal for this device, while node 1 is the positive terminal.

- AT This device supports all three analysis types (AT), namely IV, PQR and PQP. The equations for these analysis types are described below. All power grid devices, of all types, in a Xyce netlist must use the same analysis type. This constraint is not checked during netlist parsing. Violation of this constraint may cause unpredictable results.
- B Branch susceptance, given in per unit. As discussed in the Equation section below, the susceptance value given on the branch description lines in IEEE Common Data Format (CDF) files is split equally between terminals 1 and 2.
- **R** Branch resistance, given in per unit.
- **X** Branch reactance, given in per unit.

Table 2-157. PowerGridBranch Device Instance Parameters

| Parameter | Description              | Units    | Default |
|-----------|--------------------------|----------|---------|
| AT        | Analysis Type            | _        | 'PQP'   |
| В         | Branch Shunt Susceptance | per unit | 0       |
| R         | Branch Resistance        | per unit | 0       |
| X         | Branch Reactance         | per unit | 0       |

# **PowerGridBranch Device Parameters**

#### **PowerGridBusShunt**

#### **Examples**

YPowerGridBusShunt pg1\_2 VR1 VR2 VI1 VI2 AT=IV R=0.05 B=0.1 X=0.05 YPGBS pg1\_2a VR1 VR2 VI1 VI2 AT=IV R=0.05 B=0.1 X=0.05 YPowerGridBusShunt pg1\_2b VR1 VR2 VI1 VI2 AT=PQR R=0.05 B=0.1 X=0.05 YPGBS pg1\_2c VR1 VR2 VI1 VI2 AT=PQR R=0.05 B=0.1 X=0.05 YPowerGridBusShunt pg1\_2d Th1 Th2 VM1 VM2 AT=PQP R=0.05 B=0.1 X=0.05 YPGBS pg1\_2e Th1 Th2 VM1 VM2 AT=PQP R=0.05 B=0.1 X=0.0

# Parameters and Options

#### type

The device type has a verbose (PowerGridBusShunt) and a shortened (PGBS) form. Their usage may be mixed within a netlist.

#### name

Name of the device instance. This must be present, and unique amongst the PowerGridBusShunt devices in the netlist.

# input node

There are two input nodes, <input node1> and <input node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the Equivalent Real Form (ERF) described below in the equation subsections. For IV and PQR formats, <input node1> is the real part (VR) of the voltage at terminal 1 while <input node2> is the imaginary part (VI) of the voltage at terminal 1. For PQP format, <input node1> is the angle ( $\Theta$  or Th) of the voltage at terminal 1 while <input node2> is the magnitude (VM or |V|) of the voltage at terminal 1. Finally, by analogy to other Xyce devices, node 1 can be considered as the positive terminal for this device, while node 2 is the negative terminal.

#### output node

There are two output nodes, <output node1> and <output node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the ERF described below in the equation subsections. For IV and PQR formats, <output node1> is the real part (VR) of the voltage at terminal 2 while <output node2> is the imaginary part (VI) of the voltage at terminal 2. For PQP format, <output node1> is the angle ( $\Theta$  or Th) of the voltage at terminal 2 while <output node2> is the magnitude (VM or |V|) of the voltage at terminal 2. Finally, by analogy to other Xyce devices, node 2 can be considered as the negative terminal for this device, while node 1 is the positive terminal.

- AT This device supports all three analysis types (AT), namely IV, PQR and PQP. The equations for these analysis types are described below. All power grid devices, of all types, in a Xyce netlist must use the same analysis type. This constraint is not checked during netlist parsing. Violation of this constraint may cause unpredictable results.
- B Shunt susceptance, given in per unit.

## **G** Shunt conductance, given in per unit.

Table 2-158. PowerGridBusShunt Device Instance Parameters

| Parameter | Description       | Units    | Default |
|-----------|-------------------|----------|---------|
| AT        | Analysis Type     | _        | 'PQP'   |
| В         | Shunt Susceptance | per unit | 0       |
| G         | Shunt Conductance | per unit | 0       |

## **Bus Shunt Device Parameters**

## PowerGridTransformer

| Instance Form | Y <type> <name> <input node1=""/> <output node1=""><br/>+ <input node2=""/> <output node2=""> [control node] [device parameters]</output></output></name></type>   |
|---------------|--|
|               | - The hodes today [control hode] [device parameters]   |
| Examples      | YPowerGridTransformer pg1_2 VR1 VR2 VI1 VI2 AT=IV R=0.05 X=0.05 + TR=0.9 PS=0.1 YPGTR pg1_2a VR1 VR2 VI1 VI2 AT=IV R=0.05 X=0.05 TR=0.9 PS={18*PI/180} YPowerGridTransformer pg1_2b VR1 VR2 VI1 VI2 AT=PQR R=0.05 X=0.05 + TR=0.9 PS=0.1 YPGTR pg1_2c VR1 VR2 VI1 VI2 AT=PQR R=0.05 B=0.1 X=0.05 TR=0.9 PS=0.3 YPowerGridTransformer pg1_2d Th1 Th2 VM1 VM2 AT=PQP + R=0.05 X=0.05 PS={18*PI/180} YPGTR pg1_2e Th1 Th2 VM1 VM2 AT=PQP R=0.05 X=0.0 TR=0.9 PS=0.1 YPGTR pg1_2f Th1 Th2 VM1 VM2 N AT=PQP R=0.05 X=0.0 TT=VT PS=0.1 YPGTR pg1_2g Th1 Th2 VM1 VM2 Phi AT=PQP R=0.05 X=0.0 TT=PS TR=0.9 |

# Parameters and Options

## type

The device type has a verbose (PowerGridTransformer) and a shortened (PGTR) form. Their usage may be mixed within a netlist.

#### name

Name of the device instance. This must be present, and unique amongst the PowerGridTransformer devices in the netlist.

# input node

There are two input nodes, <input node1> and <input node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the Equivalent Real Form (ERF) described below in the equation subsections. For IV and PQR formats, <input node1> is the real part (VR) of the voltage at terminal 1 while <input node2> is the imaginary part (VI) of the voltage at terminal 1. For PQP format, <input node1> is

the angle ( $\Theta$  or Th) of the voltage at terminal 1 while <input node2> is the magnitude (VM or |V|) of the voltage at terminal 1. Finally, by analogy to other Xyce devices, node 1 can be considered as the positive terminal for this device, while node 2 is the negative terminal.

## output node

There are two output nodes, <output node1> and <output node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the ERF described below in the equation subsections. For IV and PQR formats, <output node1> is the real part (VR) of the voltage at terminal 2 while <output node2> is the imaginary part (VI) of the voltage at terminal 2. For PQP format, <output node1> is the angle ( $\Theta$  or Th) of the voltage at terminal 2 while <output node2> is the magnitude (VM or |V|) of the voltage at terminal 2. Finally, by analogy to other Xyce devices, node 2 can be considered as the negative terminal for this device, while node 1 is the positive terminal.

#### control input

This is an optional node. However, it must be specified on the instance line if the transformer type (TT) is set to either 2 or 3. It does not exist, and must not be specified on the instance line, for the default of TT=1. The use of the control input node is covered under the definition of the TT instance parameter.

- AT This device supports all three analysis types (AT), namely IV, PQR and PQP. The equations for these analysis types are described below. All power grid devices, of all types, in a Xyce netlist must use the same analysis type. This constraint is not checked during netlist parsing. Violation of this constraint may cause unpredictable results.
- PS Phase shift given in radians. As illustrated above, PS={18\*PI/180} is a convenient syntax for converting between decimal degrees and radians on a Xyce instance line. This instance parameter is ignored if TT=3, since the phase shift is set by the optional control node in that case.
- **R** Resistance, given in per unit.
- TR Turns ratio, given in per unit. This instance parameter is ignored if TT=2, since this value is set by the optional control node in that case..
- **x** Reactance, given in per unit.
- TTT This is the "Transformer Type". It allows the user to implement tap-changing or phase-shifting transformers, by attaching an appropriate control-circuit to the control input node. The allowed values for TT are FT, VT or PS, with default value of FT. Any other values will cause a netlist parsing error. A transformer type of FT has a fixed turns-ratio, and is a four-terminal device with two input nodes (<input node1> and <input node2>) and two output nodes (<output node1> and <output node2>). Let the effective complex turns ratio be  $r = m + jp = n*(cos(\phi) + j*sin(\phi))$ . The transformer type of VT exposes the n variable as the control input

node, and hence can operate with a variable turns-ratio. The transformer type of PS exposes the  $\phi$  variable as the control input node, and hence can act as a phase shifter. The instantaneous value of n (or  $\phi$ ) can be set to the voltage applied to the control input node. There will be no current draw into (or out of) the control input node. This device model does not yet support simultaneously varying both n and  $\phi$ .

Table 2-159. PowerGridTransformer Device Instance Parameters

| Parameter | Description             | Units    | Default |
|-----------|-------------------------|----------|---------|
| AT        | Analysis Type           | _        | 'PQP'   |
| PS        | Phase Shift             | rad      | 0       |
| R         | Resistance              | per unit | 0       |
| TR        | Transformer Turns Ratio | per unit | 1       |
| TT        | Transformer Type        | -        | 'FT'    |
| X         | Reactance               | per unit | 0       |

#### **Transformer Device Parameters**

#### **PowerGridGenBus**

| Instance Form | <pre>Y<type> <name> <input node1=""/> <output node1=""> + <input node2=""/> <output node2=""> [device parameters]</output></output></name></type></pre> |
|---------------|---|
| Examples      | YPowerGridGenBus GenBus1 Th1 0 VM1 0 AT=PQP VM=1.045 P=0.4 YPGGB GenBus2 Th2 GND VM2 GND AT=PQP VM=1.045 P=0.4  |

# Parameters and Options

#### type

The device type has a verbose (PowerGridGenBus) and a shortened (PGGB) form. Their usage may be mixed within a netlist.

#### name

Name of the device instance. This must be present, and unique amongst the PowerGridGenBus devices in the netlist.

## input node

There are two input nodes, <input node1> and <input node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the Equivalent Real Form (ERF) described below in the equation subsections. For IV and PQR formats, <input node1> is the real part (VR) of the voltage at terminal 1 while <input node2> is the imaginary part (VI) of the voltage at terminal 1. For PQP format, <input node1> is

the angle ( $\Theta$  or Th) of the voltage at terminal 1 while <input node2> is the magnitude (VM or |V|) of the voltage at terminal 1. Finally, by analogy to other Xyce devices, node 1 can be considered as the positive terminal for this device, while node 2 is the negative terminal.

### output node

There are two output nodes, <output node1> and <output node2>, whose definitions depend on the AnalysisType (AT) specified. Both nodes must be specified. This device can be viewed as a generalized 4-port resistor, using the ERF described below in the equation subsections. For IV and PQR formats, <output node1> is the real part (VR) of the voltage at terminal 2 while <output node2> is the imaginary part (VI) of the voltage at terminal 2. For PQP format, <output node1> is the angle ( $\Theta$  or Th) of the voltage at terminal 2 while <output node2> is the magnitude (VM or |V|) of the voltage at terminal 2. Finally, by analogy to other Xyce devices, node 2 can be considered as the negative terminal for this device, while node 1 is the positive terminal.

- AT This device currently only supports the PQP analysis type (AT). The equations for the PQP analysis type are described below. All power grid devices, of all types, in a Xyce netlist must use the same analysis type. This constraint is not checked during netlist parsing. Violation of this constraint may cause unpredictable results.
- P Generator Output Power, given in per unit. As noted below, positive real power (P) and positive reactive power (Q) flow out of the positive (<input node1> and <input node2>) terminals into the power grid. This is opposite from the normal convention for voltage and current sources in Xyce and SPICE.

### QLED

This is the Q-Limit Enforcement Delay. It is only used if either QMAX or QMIN is specified. The Q-Limits are not enforced for the first QLED Newton iterations of the DC Operating Point (DCOP) calculation. This may be useful if a given generator bus has, for example, a very small value of QMIN [37]. If QMAX or QMIN is specified and QLED is omitted then the default QLED value of 0 is used.

### **QMAX**

The upper limit on the reactive power (Q) flow into the power grid, given in per unit. If this parameter is omitted on the instance line then no upper limit on the reactive power flow is enforced. It is recommended that either both QMAX and QMIN be specified or that both be omitted.

### QMIN

The lower limit on the reactive power (Q) flow into the power grid, given in per unit. If this parameter is omitted on the instance line then no lower limit on the reactive power flow is enforced. It is recommended that either both QMAX and QMIN be specified or that both be omitted.

**VM** Fixed voltage magnitude, given in per unit.

Table 2-160. PowerGridGenBus Device Instance Parameters

| Parameter | Description               | Units    | Default |
|-----------|---------------------------|----------|---------|
| AT        | Analysis Type             | _        | 'PQP'   |
| P         | Generator Output Power    | per unit | 1       |
| QLED      | Q-Limit Enforcement Delay | _        | 0       |
| QMAX      | Reactive Power Max Limit  | per unit | 1       |
| QMIN      | Reactive Power Min Limit  | per unit | 0       |
| VM        | Voltage Magnitude         | per unit | 1       |

### **Generator Bus Device Parameters**

**Branch Current and Power Accessors** This version of the Power Grid devices does not support the branch current accessor, I(), or the power accessors, P() or W().

**Compatibility with .STEP** . STEP should work with all of the instance parameters for the power grid devices. The two exceptions are the Analysis Type (AT) for all of the power grid devices and the Transformer Type (TT) for the Transformer device. Those two parameters must be constant for all steps.

**Model Limitations and Caveats** The following features are not supported by this release of the Power Grid device models.

- The Generator Bus device model only supports the PQ Polar format. So, reactive power (QMAX and QMIN) limits in the Generator Bus device model are also only supported for that format.
- Magnetizing susceptance for transformers.
- Certain instance parameters, or combinations of instance parameters, will cause errors during netlist parsing. In particular, either B, R or X must be non-zero for the Branch device. Either B or G must be non-zero for the Bus Shunt device. Either R or X must be non-zero for the Transformer device. TR must not be zero for the Transformer device. VM must be positive for the Generator Bus device.

**Equivalent Real Form** An Equivalent Real Form (ERF) must be used to make the complex-valued voltage-current and power-flow equations compatible with the real-valued solvers used by Xyce. The equations given below use a K1 ERF [36], which solves the complex-valued system of equations I = YV as follows. Let Y = (g + jb),  $V = (V_R + jV_I)$  and  $I = (I_R + jI_I)$ . Then the equivalent set of real-valued equations is:

$$\begin{bmatrix} I_R \\ I_I \end{bmatrix} = \begin{bmatrix} g & -b \\ g & b \end{bmatrix} \begin{bmatrix} V_R \\ V_I \end{bmatrix}$$
 (2.25)

**Y Matrices for Power Grid Branch and Bus Shunt** The Y-Matrix for the PowerGridBranch device can be expressed as follows where  $A = (R + jX)^{-1}$ , R is the branch resistance, X is the branch reactance and B is the branch shunt susceptance given on the device's instance line:

$$\begin{bmatrix} Y_{11} & Y_{12} \\ Y_{21} & Y_{22} \end{bmatrix} = \begin{bmatrix} g_{11} + jb_{11} & g_{12} + jb_{12} \\ g_{21} + jb_{21} & g_{22} + jb_{22} \end{bmatrix} = \begin{bmatrix} A & -A + 0.5j * B \\ -A + 0.5j * B & A \end{bmatrix}$$
(2.26)

The Y-Matrix for the PowerGridBusShunt device can be expressed as follows where G is the bus

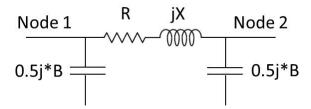


Figure 2-4. Lumped  $\Pi$  Model for PowerGridBranch.

shunt conductance and B is the bus shunt susceptance given on the device's instance line:

$$\begin{bmatrix} Y_{11} & Y_{12} \\ Y_{21} & Y_{22} \end{bmatrix} = \begin{bmatrix} g_{11} + jb_{11} & g_{12} + jb_{12} \\ g_{21} + jb_{21} & g_{22} + jb_{22} \end{bmatrix} = \begin{bmatrix} G + jB & -G - jB \\ -G - jB & G + jB \end{bmatrix}$$
(2.27)

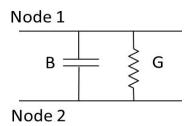


Figure 2-5. Equivalent Circuit for PowerGridBusShunt.

**Equations Common to Power Grid Branch and Bus Shunt** The PowerGridBranch and PowerGridBusShunt devices use the same basic equations to model voltage and current flow or voltage and power flow. The differences are in the Y-Matrices described above. There are three options for the equations used, namely I=YV, PQ Polar and PQ Rectangular.

For the I=YV format, the device equations for the PowerGridBranch and PowerGridBusShunt devices are as follows, where the  $g_{ij}$  and  $b_{ij}$  terms are given above. Also,  $V_{R1}$  and  $V_{I1}$  are the real and imaginary parts of the voltage at terminal 1.  $I_{R1}$  and  $I_{I1}$  are the real and imaginary parts of the current at terminal 1.

$$\begin{bmatrix} I_{R1} \\ I_{R2} \\ I_{I1} \\ I_{I2} \end{bmatrix} = \begin{bmatrix} g_{11} & g_{12} & -b_{11} & -b_{12} \\ g_{21} & g_{22} & -b_{21} & -b_{22} \\ b_{11} & b_{12} & g_{11} & g_{12} \\ b_{21} & b_{22} & g_{21} & g_{22} \end{bmatrix} \begin{bmatrix} V_{R1} \\ V_{R2} \\ V_{I1} \\ V_{I2} \end{bmatrix}$$
(2.28)

For the PQ Rectangular format, the device equations are nonlinear [37].

$$P_1 = g_{11}(V_{R1}^2 + V_{I1}^2) + V_{R1}(g_{12} * V_{R2} - b_{12} * V_{I2}) + V_{I1}(b_{12} * V_{R2} + g_{12} * V_{I2})$$
(2.29)

$$P_2 = g_{22}(V_{R2}^2 + V_{I2}^2) + V_{R2}(g_{21} * V_{R1} - b_{21} * V_{I1}) + V_{I2}(b_{21} * V_{R1} + g_{21} * V_{I1})$$
(2.30)

$$Q_1 = -b_{11}(V_{R1}^2 + V_{I1}^2) + V_{I1}(g_{12} * V_{R2} - b_{12} * V_{I2}) + V_{R1}(b_{12} * V_{R2} + g_{12} * V_{I2})$$
(2.31)

$$Q_2 = -b_{22}(V_{R2}^2 + V_{I2}^2) + V_{I2}(g_{21} * V_{R1} - b_{21} * V_{I1}) + V_{R2}(b_{21} * V_{R1} + g_{21} * V_{I1})$$
(2.32)

For the PQ Polar format, the device equations are also nonlinear [37]. Define  $|V_1|$  as the voltage magnitude at terminal 1 and  $\Theta_1$  as the voltage angle at terminal 1.

$$P_1 = g_{11} * |V_1|^2 + |V_1| * |V_2| * (g_{12} * cos(\Theta_1 - \Theta_2) + b_{12} * sin(\Theta_1 - \Theta_2))$$
(2.33)

$$P_2 = g_{22} * |V_2|^2 + |V_2| * |V_1| * (g_{21} * cos(\Theta_2 - \Theta_1) + b_{21} * sin(\Theta_2 - \Theta_1))$$
(2.34)

$$Q_1 = -b_{11} * |V_1|^2 + |V_1| * |V_2| * (g_{12} * sin(\Theta_1 - \Theta_2) - b_{12} * cos(\Theta_1 - \Theta_2))$$
(2.35)

$$Q_2 = -b_{22} * |V_2|^2 + |V_2| * |V_1| * (g_{21} * sin(\Theta_2 - \Theta_1) - b_{21} * cos(\Theta_2 - \Theta_1))$$
(2.36)

**Equations for Power Grid Transformer** The equations for the PowerGridTransformer device are similar to those used by the PowerGridBranch and PowerGridBusShunt devices. The circuit diagram for the PowerGridTransformer is shown below.

For I=YV and PQ Rectangular formats, the equations are the same as for the PowerGridBranch and PowerBusBusShunt devices. However, the following Y-Matrix is used where where  $A = (R + jX)^{-1}$ , R is the resistance, X is the reactance, n is the turns ratio (which is the TR instance parameter) and  $\phi$  is the phase shift in radians (which is the PS instance parameter).

For the I=YV and PQ Rectangular formats, the Y matrix is not symmetric and is given by the following [38]. Let the effective complex turns ratio be  $r = m + jp = n*(cos(\phi) + j*sin(\phi))$ :

$$\begin{bmatrix} Y_{11} & Y_{12} \\ Y_{21} & Y_{22} \end{bmatrix} = \begin{bmatrix} g_{11} + jb_{11} & g_{12} + jb_{12} \\ g_{21} + jb_{21} & g_{22} + jb_{22} \end{bmatrix} = \begin{bmatrix} A * (m^2 + p^2)^{-1} & -A * (m - jp)^{-1} \\ -A * (m + jp)^{-1} & A \end{bmatrix}$$
(2.37)

The voltage-current and power flow equations for the I=YV and PQ Rectangular formats are then the same as for the PowerGridBranch and PowerGridBusShunt devices, with the modified Y-matrix parameters given above.

For the PQ Polar format, the Y matrix is not symmetric and is given by [37]:

$$\begin{bmatrix} Y_{11} & Y_{12} \\ Y_{21} & Y_{22} \end{bmatrix} = \begin{bmatrix} g_{11} + jb_{11} & g_{12} + jb_{12} \\ g_{21} + jb_{21} & g_{22} + jb_{22} \end{bmatrix} = \begin{bmatrix} A * n^{-2} & -A * n^{-1} \\ -A * n^{-1} & A \end{bmatrix}$$
(2.38)

The power flow equation for PO Polar format are then:

$$P_1 = g_{11} * |V_1|^2 + |V_1| * |V_2| * (g_{12} * cos(\Theta_1 - \Theta_2 - \phi) + b_{12} * sin(\Theta_1 - \Theta_2 - \phi))$$
(2.39)

$$P_2 = g_{22} * |V_2|^2 + |V_2| * |V_1| * (g_{21} * cos(\Theta_2 - \Theta_1 + \phi) + b_{21} * sin(\Theta_2 - \Theta_1 + \phi))$$
(2.40)

$$Q_1 = -b_{11} * |V_1|^2 + |V_1| * |V_2| * (g_{12} * sin(\Theta_1 - \Theta_2 - \phi) - b_{12} * cos(\Theta_1 - \Theta_2 - \phi))$$
 (2.41)

$$Q_2 = -b_{22} * |V_2|^2 + |V_2| * |V_1| * (g_{21} * sin(\Theta_2 - \Theta_1 + \phi) - b_{21} * cos(\Theta_2 - \Theta_1 + \phi))$$
 (2.42)

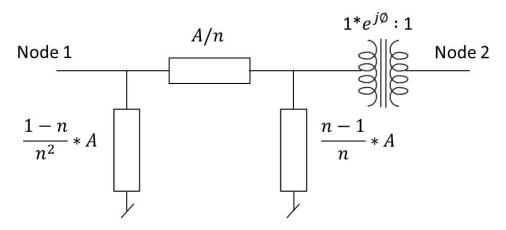


Figure 2-6. Equivalent Circuit for PowerGridTransformer.

**Equations for Power Grid Gen Bus** The PowerGridGenBus is an active device that functions as an ideal generator with a fixed power output (P) and voltage magnitude (VM). Reactive power (QMAX) and QMIN limits are also supported. The device equations for the PQ Polar format are as follows [37]. The other solution formulations are not supported in this release. If reactive power limits are not being enforced then:

$$P_1 = P \tag{2.43}$$

$$|V_1| = VM \tag{2.44}$$

If reactive power limits are being enforced then  $P_1$  is still held constant but the behavior of the  $V_1$  terminal changes between a constant-voltage and a constant-current source. In particular,  $|V_1| = VM$  only if QMIN  $< Q_1 < QMAX$ . Otherwise,  $|V_1|$  is unconstrained and the appropriate QMIN or QMAX value is enforced at the  $V_1$  terminal instead.

The convention for Power Grids is that positive power is injected into the grid. So, positive real (P) and reactive power (Q) flow out of the positive terminals (inputNode 1 and inputNode 2). This is reversed from the normal convention for current direction for voltage and current sources in either Xyce or SPICE.

### 2.3.32. Memristor Device



### **Symbol**

Instance Form ymemristor <name> <(+) node> <(-) node> <model>

### **Model Form**

.MODEL <model name> MEMRISTOR level=2 [model parameters]

### **Examples**

ymemristor mr1 n1 n2 mrm2

.model mrm2 memristor level=2 ron=50 roff=1000

- + koff=1.46e-18 kon=-4.68e-22
- + alphaoff=10 alphaon=10 wc=1.0e-12
- + ioff=115e-6 ion=-8.9e-6 xscaling=1.0e9 wt=4

ymemristor mr2 n1 n2 mrm3 xo=0.11

.MODEL mrm3 memristor level=3 a1=0.17 a2=0.17 b=0.05 vp=0.16 vn=0.15 + ap=4000 an=4000 xp=0.3 xn=0.5 alphap=1 alphan=5 eta=1

ymemristor mr3 n1 n2 mrm4

- .model mrm4 memristor level=4
- + fxpdata=fxp\_table.csv
- + fxmdata=fxm\_table.csv
- + I1=85.37e-6 I2=90.16e-6 V1=0.265 V2=0.265 G0=130.72e-6
- + VP=0.7 VN=1.0 d1=9.87 d2=-4.82
- + C1=1000 C2=1000

# Parameters and Options

- (+) node
- (-) node

Polarity definition for a positive voltage across the memristor. The first node is defined as positive. Therefore, the voltage across the component is the first node voltage minus the second node voltage.

#### **Comments**

The level=2 memristor device is an implementation of the TEAM formulation described in [39] and [40]. The level=3 memristor device is an implementation of the Yakopcic formulation described in [41]. The level=4 memristor device is an implementation of the Piecewise Empirical Model described in [42].

Positive current flows from the (+) node through the device to the (-) node. The power through the device is calculated with  $I \cdot \Delta V$  where the voltage drop is calculated as  $(V_+ - V_-)$  and positive current flows from  $V_+$  to  $V_-$ .

**Device Equations for TEAM Formulation** The current voltage relationship for the TEAM formulation can be linear or nonlinear and this is selectable with the instance parameter IVRELATION. The default is the linear relationship which is:

$$v(t) = \left[ R_{ON} + \frac{R_{OFF} - R_{ON}}{x_{OFF} - x_{ON}} (x - x_{ON}) \right] i(t)$$
 (2.45)

The non-linear relationship is:

$$v(t) = R_{ON}e^{\lambda(x - x_{ON})/(x_{OFF} - x_{ON})}i(t)$$
(2.46)

where  $\lambda$  is defined as:

$$\frac{R_{OFF}}{R_{ON}} = e^{\lambda} \tag{2.47}$$

In the above equations x represents a doped layer whose growth determines the overall resistance of the device. The equation governing the value of x is:

$$\frac{dx}{dt} = \begin{cases}
k_{OFF} \left(\frac{i}{i_{OFF}} - 1\right)^{\alpha_{OFF}} f_{OFF}(x) & 0 < i_{OFF} < i \\
0 & i_{ON} < i < i_{OFF} \\
k_{ON} \left(\frac{i}{i_{on}} - 1\right)^{\alpha_{on}} f_{ON}(x) & i < i_{ON} < 0
\end{cases} \tag{2.48}$$

The functions  $f_{ON}(x)$  and  $f_{OFF}(x)$  are window functions designed to keep x within the defined limits of  $x_{ON}$  and  $x_{OFF}$ . Four different types of window functions are available and this is selectable with the model parameter  $\mathbb{WT}$ . Note that the TEAM memristor device is formulated to work best with the TEAM, Kvatinsky, window function  $\mathbb{WT}=4$ . Other window functions should be used with caution.

**Device Equations for Yakopcic Formulation** The current voltage relationship for the Yakopcic memristor device is: [41]

$$I(t) = \begin{cases} a_1 x(t) \sinh(bV(t)) & V(t) \ge 0\\ a_2 x(t) \sinh(bV(t)) & V(t) < 0 \end{cases}$$
 (2.49)

$$g(V(t)) = \begin{cases} A_p \left( \exp^{V(t)} - \exp^{V_p} \right) & V(t) > V_p \\ -A_n \left( \exp^{-V(t)} - \exp^{V_n} \right) & V(t) < -V_n \\ 0 & -V_n \le V(t) \le V_p \end{cases}$$
 (2.50)

The internal state variable, x, is governed by the equation:

$$\frac{dx}{dt} = ng(V(t))f(x(t)) \tag{2.51}$$

where f(x) is defined by:

$$f(x) = \begin{cases} \exp^{-\alpha_p(x-x_p)} w_p(x,x_p) & x \ge x_p \\ 1 & x \le x_p \end{cases}$$
 (2.52)

$$f(x) = \begin{cases} \exp^{\alpha_n(x + x_n - 1)} w_n(x, x_n) & x \le 1 - x_n \\ 1 & x > 1 - x_n \end{cases}$$
 (2.53)

$$w_p(x, x_p) = \frac{x_p - x}{1 - x_p} + 1 \tag{2.54}$$

$$w_n(x, x_n) = \frac{x}{1 - x_n} \tag{2.55}$$

Note, the quantities,  $x_p$ ,  $x_n$ ,  $\alpha_p$ ,  $\alpha_n$ ,  $A_p$ ,  $A_n$ ,  $A_1$ ,  $A_2$  and  $A_2$  are model parameters that can be specified in the device's model block.

**Device Equations for the PEM Formulation** The PEM memristor device is similar to the TEAM and Yakopcic formulations in that an internal state variable, x, is used to capture the device's response to its history.

The I-V relationship is

$$I = xh(V) (2.56)$$

and h(V) is defined by:

$$h(V) = I_1 * exp(V/V_1) - I_2 * exp(-V/V_2) + G_0V - (I_1 - I_2)$$
(2.57)

where  $I_1$ ,  $I_2$ ,  $V_1$ ,  $V_2$  and  $G_0$  are model parameters.

The internal variable, x, is defined by:

$$\frac{dx}{dt} = G(V)f(x) \tag{2.58}$$

with

$$G(V) = \begin{cases} C_1 \left( \exp^{d_1[V(t) - V_p]} - 1 \right) & V > V_p \\ C_2 \left( \exp^{d_2[V(t) - V_n]} - 1 \right) & V < -V_n \\ 0 & -V_n \le V(t) \le V_p \end{cases}$$
 (2.59)

Finally, the function f(x) is defined by a user supplied set set data which is used with linear interpolation to find the current value of f(x). Separate data sets are used for forward bias and reverse bias.

$$f(x) = \begin{cases} F^{+} \text{dataset} & V > 0 \\ F^{-} \text{dataset} & V < 0 \end{cases}$$
 (2.60)

Table 2-161. MemristorTEAM Device Instance Parameters

| Parameter  | Description   | Units | Default |
|------------|---|-------|---------|
| IVRELATION | IV relationship to use, 0 is linear, 1 is nonlinear | _     | 0       |

### **Device Parameters for TEAM Formulation**

Table 2-162. MemristorTEAM Device Model Parameters

| Parameter | Description  | Units | Default  |
|-----------|--|-------|----------|
| ALPHAOFF  | Modeling Coefficient   | _     | 3        |
| ALPHAON   | Modeling Coefficient   | _     | 3        |
| AOFF      | Window Function Parameter (window 4)   | m     | 3e-09    |
| AON       | Window Function Parameter (window 4)   | m     | 0        |
| D         | Window Function Parameter (windows 1, 2 and 3)                                       | _     | 0.000115 |
| IOFF      | Current scale in off state   | Ω     | 0.000115 |
| ION       | Current scale in On state  | A     | 8.9e-06  |
| J         | Window Function Parameter (window 3)   | _     | 0.000115 |
| KOFF      | Modeling Coefficient   | m/s   | 8e-13    |
| KON       | Modeling Coefficient   | m/s   | -8e-13   |
| P         | Window Function Parameter (windows 1, 2 and 3)                                       | _     | 0.000115 |
| ROFF      | Resistence in off state  | Ω     | 1000     |
| RON       | Resistence in on state   | Ω     | 50       |
| WC        | Window Function Parameter (window 4)   | m     | 1.07e-12 |
| WT        | Type of windowing function: 0-None, 1-Jogelkar, 2-Biolek, 3-Prodromakis, 4-Kvatinsky | _     | 0        |
| XOFF      | Modeling Coefficient   | m     | 3e-09    |
| XON       | Modeling Coefficient   | m     | 0        |
| XSCALING  | Scaling for x variable. For example 1e9 if x will be in units of nanometers.         | _     | 1        |

## **Model Parameters for TEAM Formulation**

Table 2-163. MemristorYakopcic Device Instance Parameters

| Parameter | Description                           | Units | Default |
|-----------|---------------------------------------|-------|---------|
| XO        | Initial value for internal variable x | _     | 0       |

# **Device Parameters for Yakopcic Formulation**

Table 2-164. MemristorYakopcic Device Model Parameters

| Parameter | Description  | Units | Default |
|-----------|--|-------|---------|
| A1        | Dielectric layer thickness parameter [dimensionless] | -     | 1       |
| A2        | Dielectric layer thickness parameter [dimensionless] | _     | 1       |
| ALPHAN    | State variable motion.                               | _     | 1       |
| ALPHAP    | State variable motion.                               | _     | 1       |

Table 2-164. MemristorYakopcic Device Model Parameters

| AN       Negative Voltage Threshold Magnitude Parameter       -       1         AP       Positive Voltage Threshold Magnitude Parameter       -       1         B       Curvature in I-V relation. Relates to how much conduction in the device is Ohmic and versus tunnel barrier.       -       1         ETA       State variable motion relative to voltage.       -       1         RESDELTA       RTN model in resistance: Base change in resistance for RTN model in resistance: Base change in resistance for RTN scaled by R       -       0         RESDELTAGRAD       RTN model in resistance: Minimum allowed update time       s       1e-10         RESLAMBDA       RTN model in resistance (on/off)       -       6         RESSADOISE       RTN model in resistance: seed       -       0         RESSTD       RTN model in resistance: seed       -       0         RESTD       RTN model in resistance: seed       -       0         VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XDELTAGRAD       RTN model in growth: Minimum allowed update time       s       1e-10         XLAMBDA       RTN model  | Parameter    | Description   |   | Default |
|--|--------------|---|---|---------|
| B Curvature in I-V relation. Relates to how much conduction in the device is Ohmic and versus tunnel barrier.  ETA State variable motion relative to voltage 1  RESDELTA RTN model in resistance: Base change in resistance for RTN  RESDELTAGRAD RTN model in resistance: Base change in resistance for RTN scaled by R  RESDELTAGRAD RTN model in resistance: Minimum allowed update time  RESLAMBDA RTN model in resistance: Minimum allowed update time  RESNOISE RTN model in resistance (on/off) - false  RESSEED RTN model in resistance: seed - 0  RESTD RTN model in resistance: Update time s 0  VN Negative Voltage Threshold V -0.01  VP Positive Voltage Threshold V 0.01  XDELTA RTN model in growth: Base change in growth rate for RTN scaled by X  XEPTD RTN model in growth: Base change in growth for RTN scaled by X  XEPTD RTN model in growth: Minimum allowed update time s 1e-10  XLAMBDA RTN model in growth: Minimum allowed update time s 1e-10  XLAMBDA RTN model in growth: Minimum allowed update time s 1e-10  XLAMBDA RTN model in growth (on/off) - false  XN State variable motion - 1  XNOISE RTN model in growth (on/off) - false  XP State variable motion - 1  XSCALING Scaling for x variable. For example 1e9 if x will be in units of nanometers.   | AN           | Negative Voltage Threshold Magnitude Parameter      | _ | 1       |
| B       conduction in the device is Ohmic and versus tunnel barrier.       -       1         ETA       State variable motion relative to voltage.       -       1         RESDELTA       RTN model in resistance: Base change in resistance for RTN       Ω       0         RESDELTAGRAD       RTN model in resistance: Base change in resistance for RTN scaled by R       -       0         RESEPTD       RTN model in resistance: Minimum allowed update time       s       1e-10         RESLAMBDA       RTN model in resistance (on/off)       -       false         RESNOISE       RTN model in resistance: seed       -       0         RESTD       RTN model in resistance: Update time       s       0         VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTA       RTN model in growth: Base change in growth for RTN       -       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN model in growth: Base change in growth for RTN model in growth: Base change in growth for RTN model in growth: Base change in growth for RTN model in growth: Base change in growth for RTN scaled by X       -       0         XEPTD       RTN mode | AP           | Positive Voltage Threshold Magnitude Parameter      | _ | 1       |
| RESDELTA       RTN model in resistance: Base change in resistance for RTN       Ω       0         RESDELTAGRAD       RTN model in resistance: Base change in resistance for RTN scaled by R       -       0         RESEPTD       RTN model in resistance: Minimum allowed update time       s       1e-10         RESLAMBDA       RTN model: lambda       -       0         RESNOISE       RTN model in resistance (on/off)       -       false         RESSEED       RTN model in resistance: seed       -       0         VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XDELTAGRAD       RTN model in growth: Minimum allowed update time       s       1e-10         XLAMBDA       RTN model in growth: Minimum allowed update time       s       1e-10         XLAMBDA       RTN growth model: lambda       -       0         XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP  | В            | conduction in the device is Ohmic and versus tunnel | - | 1       |
| RESDELTA       for RTN       M       0         RESDELTAGRAD       RTN model in resistance: Base change in resistance for RTN scaled by R       -       0         RESEPTD       RTN model in resistance: Minimum allowed update time       s       1e-10         RESLAMBDA       RTN model: lambda       -       0         RESNOISE       RTN model in resistance (on/off)       -       false         RESSEED       RTN model in resistance: Seed       -       0         VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XDELTAGRAD       RTN model in growth: Minimum allowed update time       s       1e-10         XLAMBDA       RTN growth model: lambda       -       0         XLAMBDA       RTN growth model in growth (on/off)       -       1         XNOISE       RTN model in growth (on/off)       -       1         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in unit   | ETA          | State variable motion relative to voltage.          | _ | 1       |
| FESSELTAGRAD  For RTN scaled by R  RESEPTD  RTN model in resistance: Minimum allowed update time  RESLAMBDA  RTN model: lambda  RESNOISE  RTN model in resistance (on/off)  RESSEED  RTN model in resistance: seed  RTN model in resistance: Update time  RESTD  RTN model in resistance: Update time  RESTD  RTN model in resistance: Update time  RTN model in growth: Base change in growth rate for RTN  RTN model in growth: Base change in growth for RTN scaled by X  XEELTAGRAD  RTN model in growth: Base change in growth for RTN scaled by X  XEPTD  RTN model in growth: Minimum allowed update time  RTN model in growth: Minimum allowed update time  RTN model in growth: Minimum allowed update time  RTN growth model: lambda  RTN growth model: lambda  RTN model in growth (on/off)  RTN model in growth (on/off)  RTN scaled by X  RTN model in growth (on/off)  RTN model in growth: Scaling for x variable. For example 1e9 if x will be in units of nanometers.  RTN model in growth: seed  | RESDELTA     |   | Ω | 0       |
| time  RESLAMBDA RTN model: lambda - 0  RESNOISE RTN model in resistance (on/off) - false  RESSEED RTN model in resistance: seed - 0  RESTD RTN model in resistance: Update time s 0  VN Negative Voltage Threshold V -0.01  VP Positive Voltage Threshold V 0.01  XDELTA RTN model in growth: Base change in growth rate for RTN  XDELTA RTN model in growth: Base change in growth for RTN scaled by X  XEPTD RTN model in growth: Minimum allowed update time s 1e-10  XLAMBDA RTN growth model: lambda - 0  XN State variable motion 1  XNOISE RTN model in growth (on/off) - false  XP State variable motion 1  XSCALING RTN model in growth: For example 1e9 if x will be in units of nanometers.  XEED RTN model in growth: seed - 0   | RESDELTAGRAD |   | _ | 0       |
| RESNOISERTN model in resistance (on/off)-falseRESSEEDRTN model in resistance: seed-0RESTDRTN model in resistance: Update times0VNNegative Voltage ThresholdV-0.01VPPositive Voltage ThresholdV0.01XDELTARTN model in growth: Base change in growth rate for RTNΩ0XDELTAGRADRTN model in growth: Base change in growth for RTN scaled by X-0XEPTDRTN model in growth: Minimum allowed update times1e-10XLAMBDARTN growth model: lambda-0XNState variable motion1XNOISERTN model in growth (on/off)-falseXPState variable motion1XSCALINGScaling for x variable. For example 1e9 if x will be in units of nanometers1XSEEDRTN model in growth: seed-0  | RESEPTD      | <u>.</u>  | s | 1e-10   |
| RESSEED       RTN model in resistance: seed       -       0         RESTD       RTN model in resistance: Update time       s       0         VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XEPTD       RTN model in growth: Minimum allowed update time       s       1e-10         XLAMBDA       RTN growth model: lambda       -       0         XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       0         XSEED       RTN model in growth: seed       -       0   | RESLAMBDA    | RTN model: lambda                                   | _ | 0       |
| RESTD       RTN model in resistance: Update time       s       0         VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XEPTD       RTN model in growth: Minimum allowed update time       s       1e-10         XLAMBDA       RTN growth model: lambda       -       0         XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       1         XSEED       RTN model in growth: seed       -       0   | RESNOISE     | RTN model in resistance (on/off)                    | _ | false   |
| VN       Negative Voltage Threshold       V       -0.01         VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XEPTD       RTN model in growth: Minimum allowed update time s       s       1e-10         XLAMBDA       RTN growth model: lambda       -       0         XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       0         XSEED       RTN model in growth: seed       -       0  | RESSEED      | RTN model in resistance: seed                       | _ | 0       |
| VP       Positive Voltage Threshold       V       0.01         XDELTA       RTN model in growth: Base change in growth rate for RTN       Ω       0         XDELTAGRAD       RTN model in growth: Base change in growth for RTN scaled by X       -       0         XEPTD       RTN model in growth: Minimum allowed update time s       s       1e-10         XLAMBDA       RTN growth model: lambda       -       0         XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       1         XSEED       RTN model in growth: seed       -       0  | RESTD        | RTN model in resistance: Update time                | S | 0       |
| XDELTARTN model in growth: Base change in growth rate for RTN scaled by XΩ0XDELTAGRADRTN model in growth: Base change in growth for RTN scaled by X-0XEPTDRTN model in growth: Minimum allowed update times1e-10XLAMBDARTN growth model: lambda-0XNState variable motion1XNOISERTN model in growth (on/off)-falseXPState variable motion1XSCALINGScaling for x variable. For example 1e9 if x will be in units of nanometers1XSEEDRTN model in growth: seed-0  | VN           | Negative Voltage Threshold                          | V | -0.01   |
| RTN model in growth: Base change in growth for RTN scaled by X  EPTD RTN model in growth: Minimum allowed update time s  EXLAMBDA RTN growth model: lambda - 0  EXN State variable motion 1  EXNOISE RTN model in growth (on/off) - false  EXP State variable motion 1  EXSCALING Scaling for x variable. For example 1e9 if x will be in units of nanometers.  EXEMBLE ARTN model in growth: seed - 0   | VP           | Positive Voltage Threshold                          | V | 0.01    |
| RTN scaled by X  XEPTD RTN model in growth: Minimum allowed update time s le-10  XLAMBDA RTN growth model: lambda - 0  XN State variable motion 1  XNOISE RTN model in growth (on/off) - false  XP State variable motion 1  XSCALING Scaling for x variable. For example 1e9 if x will be in units of nanometers.  XSEED RTN model in growth: seed - 0   | XDELTA       |   | Ω | 0       |
| XLAMBDA       RTN growth model: lambda       -       0         XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       1         XSEED       RTN model in growth: seed       -       0   | XDELTAGRAD   |   | - | 0       |
| XN       State variable motion.       -       1         XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       1         XSEED       RTN model in growth: seed       -       0  | XEPTD        | RTN model in growth: Minimum allowed update time    | S | 1e-10   |
| XNOISE       RTN model in growth (on/off)       -       false         XP       State variable motion.       -       1         XSCALING       Scaling for x variable. For example 1e9 if x will be in units of nanometers.       -       1         XSEED       RTN model in growth: seed       -       0  | XLAMBDA      | RTN growth model: lambda                            | _ | 0       |
| XP     State variable motion.     -     1       XSCALING     Scaling for x variable. For example 1e9 if x will be in units of nanometers.     -     1       XSEED     RTN model in growth: seed     -     0  | XN           | State variable motion.                              | _ | 1       |
| Scaling for x variable. For example 1e9 if x will be in units of nanometers.  Scaling for x variable. For example 1e9 if x will be in units of nanometers.  1  RTN model in growth: seed – 0   | XNOISE       | RTN model in growth (on/off)                        | _ | false   |
| units of nanometers.  XSEED RTN model in growth: seed – 0  | XP           | State variable motion.                              | _ | 1       |
|  | XSCALING     |   | _ | 1       |
| XTD RTN model in growth: Update time s 0   | XSEED        | RTN model in growth: seed                           | _ | 0       |
|  | XTD          | RTN model in growth: Update time                    | s | 0       |

# **Model Parameters for Yakopcic Formulation**

**Table 2-165. MemristorPEM Device Instance Parameters** 

| Parameter | Description                           | Units | Default |
|-----------|---------------------------------------|-------|---------|
| XO        | Initial value for internal variable x | -     | 0       |

# **Device Parameters for PEM Formulation**

**Table 2-166. MemristorPEM Device Model Parameters** 

| Parameter | Description  | Units | Default     |
|-----------|--|-------|-------------|
| C1        | State variable proportionality parameter for forward bias  | -     | 1           |
| C2        | State variable proportionality parameter for negative bias | -     | 1           |
| D1        | Positive Voltage Threshold Magnitude Parameter             | _     | 1           |
| D2        | Negative Voltage Threshold Magnitude Parameter             | _     | 1           |
| FXMDATA   | File from which to read x,f-(x) data                       | _     | 'filem.dat' |
| FXPDATA   | File from which to read x,f+(x) data                       | _     | 'filep.dat' |
| G0        | Conductance factor.  | _     | 1           |
| I1        | Current Scale factor.                                      | A     | 1           |
| 12        | Current Scale factor.                                      | A     | 1           |
| V1        | Voltage Scale factor.                                      | V     | 1           |
| V2        | Voltage Scale factor.                                      | V     | 1           |
| VN        | Negative Voltage Threshold                                 | V     | -0.01       |
| VP        | Positive Voltage Threshold                                 | V     | 0.01        |

# **Model Parameters for PEM Formulation**

### 2.3.33. Subcircuit

A subcircuit can be introduced into the circuit netlist using the specified nodes to substitute for the argument nodes in the definition. It provides a building block of circuitry to be defined a single time and subsequently used multiple times in the overall circuit netlists. See Section 2.1.37 for more information about subcircuits.

Instance Form X < name > [node] \* < subcircuit name > [PARAMS: [ < name > =

<value>]\*]

**Examples** X12 100 101 200 201 DIFFAMP

XBUFF 13 15 UNITAMP

XFOLLOW IN OUT VCC VEE OUT OPAMP

XFELT 1 2 FILTER PARAMS: CENTER=200kHz

XNANDI 25 28 7 MYPWR MYGND PARAMS: IO\_LEVEL=2

# Parameters and Options

### subcircuit name

The name of the subcircuit's definition.

### PARAMS:

Passed into subcircuits as arguments and into expressions inside the subcircuit.

### **Comments**

There must be an equal number of nodes in the subcircuit call and in its definition.

Subcircuit references may be nested to any level. However, the nesting cannot be circular. For example, if subcircuit A's definition includes a call to subcircuit B, then subcircuit B's definition cannot include a call to subcircuit A.

### 2.4. TCAD Devices

Semiconductor device simulation, which is based on a coupled set of partial differential equations (PDE's) is supported in Xyce. Such devices can be invoked from the circuit netlist in a manner similar to traditional SPICE-style analog devices. One dimensional and two dimensional devices are supported, with the dimensionality determined by the device model level.

| 1D Device Form | <pre>YPDE <name> <node> [node] [model name] + [device parameters]</node></name></pre>   |
|----------------|---|
| 2D Device Form | <pre>YPDE <name> <node> <node> [node][node] [model name]  + [device parameters]</node></node></name></pre>  |
| Model Form     | .MODEL <model name=""> ZOD [model parameters]</model>   |
| Comments       | All of the PDE parameters are specified on the instance level. The model statement is used only for specifying if the device is 1D or 2D, via the level parameter. Both the 1D and the 2D devices can construct evenly-spaced meshes internally, or an unstructured mesh can be read in from an external mesh file. |
|                | The eletrode, doping and material parameters are specified using a special format that is described in the tables that are referenced in the instance parameter tables.   |

**TCAD Device Parameters** Most TCAD device parameters are specified on the instance level. The only TCAD device model parameter is the level, which specifies whether the model is one or two dimensions.

**Table 2-167. PDE Device Model Parameters** 

| Parameter | Description                                     | Units | Default |
|-----------|---|-------|---------|
| LEVEL     | Determines if the device is 1D or 2D 1=1D, 2=2D | _     | 1       |

Table 2-168. 1D PDE (level 1) Device Instance Parameters

| Parameter      | Description                             | Units            | Default     |
|----------------|---|------------------|-------------|
| AUGER          | Flag to turn on/off Auger recombination | logical<br>(T/F) | true        |
| BULKMATERIAL   | Bulk semiconductor material             | _                | 'SI'        |
| DOPINGPROFILES |   | See Table 2-173  |             |
| FERMIDIRAC     | Use Fermi-Dirac statistics.             | logical<br>(T/F) | false       |
| FIELDDEP       | If true, use field dependent mobility.  | logical<br>(T/F) | false       |
| LAYER          |   | See T            | Table 2-170 |

Table 2-168. 1D PDE (level 1) Device Instance Parameters

| Parameter          | Description  | Units              | Default        |
|--------------------|--|--------------------|----------------|
| MASKVARSTIA        | If set to true, then some variables are excluded from<br>the time integration error control calculation. | logical<br>(T/F)   | false          |
| MAXVOLTDELTA       | Maximum voltage change used by two-level Newton algorithm.   | V                  | 0.025          |
| MESHFILE           |  | _                  | 'internal.msh' |
| MOBMODEL           | Mobility model.  | _                  | 'ARORA'        |
| NODE               |  | See 7              | Гable 2-171    |
| NX                 | Number of mesh points  | _                  | 11             |
| REGION             |  | See 7              | Гable 2-174    |
| SRH                | Flag to turn on/off Shockley-Read-Hall (SRH) recombination.  | logical<br>(T/F)   | true           |
| THERMIONICEMISSION |  | logical<br>(T/F)   | false          |
| TUNNELING          |  | _                  | 'none'         |
| USEOLDNI           | Flag for using old(inaccurate) intrinsic carrier calculation.  | logical<br>(T/F)   | false          |
| VOLTLIM            | Flag to apply voltage limiting. This is only relevant for an experimental two-level Newton solver.       | logical<br>(T/F)   | false          |
|                    | Doping Parameters  |                    |                |
| DOPING_FILE        | File containing doping profile.  | _                  | 'NOFILE'       |
| GRADED             | Flag for graded junction vs. abrupt junction. – (1/true=graded, 0/false=abrupt)                          | logical<br>(T/F)   | false          |
| NA                 | Acceptor doping level  | $\mathrm{cm}^{-3}$ | 1e+15          |
| ND                 | Donor doping level   | $\mathrm{cm}^{-3}$ | 1e+15          |
| NDOPE_FILE         | File containing doping profile for N-type dopants.   | _                  | 'NOFILE'       |
| PDOPE_FILE         | File containing doping profile for P-type dopants.   | _                  | 'NOFILE'       |
| WJ                 | Junction width, if graded junction enabled.  | cm                 | 0.0001         |
|                    | Geometry Parameters  |                    |                |
| ANODE.AREA         | Anode area (used for two-terminal devices)   | $\mathrm{cm}^{-2}$ | 0              |
| AREA               | Cross sectional area of the device.  | $\mathrm{cm}^{-2}$ | 1              |
| BASE.AREA          | Base area (used for three-terminal (BJT) devices)  | $\mathrm{cm}^{-2}$ | 0              |
| BASE.LOC           | Location of base contact (necessary if running with three terminals).                                    | cm                 | 0.0005         |
| CATHODE.AREA       | Cathode area (used for two-terminal devices)   | cm <sup>-2</sup>   | 0              |
| COLLECTOR.AREA     | Collector area (used for three-terminal (BJT) devices)   | $cm^{-2}$          | 0              |
| EMITTER.AREA       | Emitter area (used for three-terminal (BJT) devices)   | $cm^{-2}$          | 0              |
| L                  | Device width. (Synonym with W parameter)   | cm                 | 0.001          |
| W                  | Device width. (Synonym with L parameter)   | cm                 | 0.001          |

Table 2-168. 1D PDE (level 1) Device Instance Parameters

| Parameter   | Description  | Units            | Default |  |  |
|---|--|------------------|---------|--|--|
|   | Temperature Parameters   |                  |         |  |  |
| TEMP  | Device temperature   | °C               | 27      |  |  |
| Model Output Parameters   |  |                  |         |  |  |
| FIRSTELECTRODEOFFSET  | This is an output parameter. It is only used if OFFSETOUTPUTVOLTAGE=true. (see description of that paramaeter  | logical<br>(T/F) | false   |  |  |
| GNUPLOTLEVEL  | Flag for gnuplot output. 0 - no gnuplot files. 1 - gnuplot files. gnuplot is an open source plotting program that is usually installed on Linux systems. gnuplot files will have the *Gnu.dat suffix, and the prefix will be thename of the device instance.   | -                | 1       |  |  |
| OFFSETOUTPUTVOLTAGE   | This is an output parameter that determines the "zero" of the potential at output. If OFFSETOUTPUTVOLTAGE=true (default) it will adjust the voltages at output so that the minimum voltage is zero. If true and also FIRSTELECTRODEOFFSET=true, then the voltage of the first electrode is the zero point. If OFFSETOUTPUTVOLTAGE=false, the output voltage sets the intrisic Fermi level to zero. Depending on circumstances each of these may be more or less convenient for plotting. | logical<br>(T/F) | true    |  |  |
| OUTPUTINTERVAL  | Time interval for tecplot output (if tecplot is enabled).  | S                | 0       |  |  |
| OUTPUTNLPOISSON   | Flag to determine if the results of the nonlinear Poisson calculation is included in the output files.   |                  | false   |  |  |
| Setting for Tecplot output: 0 - no Tecplot files 1 - Tecplot files, each output in a separate file. 2 - Tecplot file, each outputappended to a single file. Tecplot files will have the .dat suffix, and the prefix will be the name of the device instance |  | _                | 1       |  |  |
|   | Scaling Parameters   |                  |         |  |  |
| Density scalar; adjust to mitigate convergence problems. The model will do all of its scaling automatically, so it is generally not necessary to specify it manually.   |  | $cm^{-3}$        | 1e+15   |  |  |
| Fraction of the maximum doping by which density will be scaled. The model will do all of its scaling automatically, so it is generally not necessary to specify it manually.  |  | logical<br>(T/F) | 0.1     |  |  |
| SCALEDENSITYTOMAXDOPING   | If set the density will be scaled by a fraction of the maximum doping. The model will do all of its scaling automatically, so it is generally not necessary to specify it manually.  | logical<br>(T/F) | true    |  |  |

Table 2-168. 1D PDE (level 1) Device Instance Parameters

| Parameter    | Description  | Units | Default |
|--------------|--|-------|---------|
| t0           | Time scalar; adjust to mitigate convergence problems. The model will do all of its scaling automatically, so it is generally not necessary to specify it manually.   |       | 1e-06   |
| X0           | Length scalar; adjust to mitigate convergence problems. The model will do all of its scaling automatically, so it is generally not necessary to specify it manually. |       | 1e-07   |
|              | Boundary Condition Parameters  |       |         |
| ANODE.BC     | Anode voltage boundary condition. Only used if device is uncoupled from circuit, and running in diode mode.  |       | 0.5     |
| BASE.BC      | Base voltage boundary condition. Only used if device is uncoupled from circuit, and running in BJT mode.   |       | 0       |
| CATHODE.BC   | Cathode voltage boundary condition. Only used if device is uncoupled from circuit, and running in diode mode.  |       | 0       |
| COLLECTOR.BC | Collector voltage boundary condition. Only used if device is uncoupled from circuit, and running in BJT mode.  |       | 0       |
| EMITTER.BC   | Emitter voltage boundary condition. Only used if device is uncoupled from circuit, and running in BJT mode.  |       | 0.5     |

Table 2-169. 2D PDE (level 2) Device Instance Parameters

| Parameter      | Description   | Units              | Default       |  |
|----------------|---|--------------------|---------------|--|
| BULKMATERIAL   | KMATERIAL Material of bulk material.  |                    | 'SI'          |  |
| DISPLCUR       | If true, displacement current is computed and output  |                    | false         |  |
| DOPINGPROFILES |   | See '              | Table 2-173   |  |
| MAXVOLTDELTA   | Maximum voltage change used by two-level Newton algorithm.  |                    | 0.025         |  |
| MESHFILE       | This is a required field for a 2D simulation. If the user specifies meshfile=internal.mesh, the model will create aCartesian mesh using the parameters L,W,NX and NY. If the user specifies anything else (for example meshfile=diode.msh), the model will attempt to read in a mesh file of that name. The format is assumed to be that of the SG Framework. |                    | 'internal.msh |  |
| MOBMODEL       | Mobility model.   | _                  | 'ARORA'       |  |
| NODE           |   | See '              | Table 2-172   |  |
| NX             | Number of mesh points, x-direction.   | _                  | 11            |  |
| NY             | Number of mesh points, y-direction.   | _                  | 11            |  |
| REGION         |   | See '              | Table 2-174   |  |
| TYPE           | P-type or N-type - this is only relevant if using the default dopings   |                    | 'PNP'         |  |
| USEMATRIXGID   | -   |                    | false         |  |
| USEOLDNI       | Flag for using old (inaccurate) intrinsic carrier l calculation.  |                    | false         |  |
| USEVECTORGID   |   | _                  | false         |  |
| VOLTLIM        |   | logical<br>(T/F)   | false         |  |
|                | Doping Parameters   |                    |               |  |
| GRADED         | Flag for graded junction vs. abrupt junction. – (1/true=graded, 0/false=abrupt)   | logical<br>(T/F)   | false         |  |
| NA             | Acceptor doping level   | $\mathrm{cm}^{-3}$ | 1e+15         |  |
| ND             | Donor doping level  | $\mathrm{cm}^{-3}$ | 1e+15         |  |
| WJ             | Junction width, if graded junction enabled.   | cm                 | 0.0001        |  |
|                | Geometry Parameters   |                    |               |  |
| AREA           | Cross sectional area of the device.   | $\mathrm{cm}^{-2}$ | 1             |  |
| CYL            | Flag to enable cylindrical geometry   |                    | false         |  |
| L              | Device length   | cm                 | 0.001         |  |
| W              | Device width  | cm                 | 0.001         |  |
|                | Temperature Parameters  |                    |               |  |

Table 2-169. 2D PDE (level 2) Device Instance Parameters

| Parameter   | Description  | Units            | Default |
|---|--|------------------|---------|
| TEMP  | EMP Device temperature   |                  | 27      |
|   | Model Output Parameters  |                  |         |
| GNUPLOTLEVEL  | Flag for gnuplot output. 0 - no gnuplot files. 1 - gnuplot files. gnuplot is an open source plotting program that is usually installed on Linux systems. gnuplot files will have the *Gnu.dat suffix, and the prefix will be thename of the device instance. | -                | 0       |
| INTERPGRIDSIZE  |  | _                | 20      |
| OUTPUTINTERVAL  | Time interval for tecplot output (if tecplot is enabled).  | S                | 0       |
| OUTPUTNLPOISSON   | Flag to determine if the results of the nonlinear Poisson calculation is included in the output files. Normally, this calculation is used to initialize a drift-diffusion calculation and isn't of interest.   | logical<br>(T/F) | false   |
| Setting for Tecplot output: 0 - no Tecplot files 1 - Tecplot files, each output in a separate file. 2 - Tecplot file, each outputappended to a single file. Tecplot files will have the .dat suffix, and the prefix will be the name of the device instance |  | -                | 1       |
| Flag for volume-averaged text output. 0 - no text files.  TXTDATALEVEL 1 - text files. txtdataplot files will have the *.txt suffix, and the prefix will be the name of the device instance.  |  | _                | 1       |
|   | Scaling Parameters   |                  |         |
| X0  | Length scalar; adjust to mitigate convergence problems. The model will do all of its scaling automatically, so it is generally not necessary to specify it manually.   | cm               | 0.0001  |
|   | <b>Boundary Condition Parameters</b>   |                  |         |
| CONSTBOUNDARY   |  | _                | false   |

Table 2-170. LAYER Composite Parameters

| Parameter         | Description | Units | Default   |
|-------------------|-------------|-------|-----------|
| CON               |             | -     | 1.42248   |
| ConductionBandDOS |             | _     | 2.89e+19  |
| DIEL              |             | -     | 13.1      |
| ELMOB0            |             | _     | 2240      |
| ELVSAT            |             | _     | 7.7e+06   |
| EMASS             |             | _     | 0.067     |
| GRADEDWIDTH       |             | _     | 0         |
| HMASS             |             | _     | 0.5       |
| номов0            |             | _     | 30        |
| HOVSAT            |             | _     | 7.7e+06   |
| MATERIAL          |             | _     | 'gaas'    |
| NAME              |             | _     | 'EMITTER' |
| NARCO             |             | _     | 0.047     |
| NARVA             |             | _     | 0.047     |
| NDOPE             |             | _     | 0         |
| NI                |             | _     | 1.79e+06  |
| NX                |             | _     | 25        |
| PDOPE             |             | _     | 5e+19     |
| VAL               |             | _     | 0         |
| ValenceBandDOS    |             | _     | 2.66e+19  |
| WIDTH             |             | _     | 1e-06     |

# **Layer Parameters**

**Table 2-171. NODE Composite Parameters** 

| Parameter Description |  | Units | Default     |
|-----------------------|--|-------|-------------|
| AREA                  |  | _     | 0           |
| BC                    | Carrier density boundary condition type (dirichlet or neumann) | -     | 'dirichlet' |
| LOCATION              |  | _     | 0           |
| MATERIAL              | Contact material   | _     | 'neutral'   |
| NAME                  | Electrode name   | _     | 'anode'     |
| OXIDEBNDRYFLAG        | Oxide layer boolean  | _     | false       |
| SIDE                  | Side specification (left or right)                             | _     | 'left'      |
|                       |  |       |             |

# **Electrode Parameters 1D**

**Table 2-172. NODE Composite Parameters** 

| Parameter      | Description  |    | Default     |
|----------------|--|----|-------------|
| BC             | Carrier density boundary condition type (dirichlet or neumann) |    | 'dirichlet' |
| END            | Ending location  | cm | 0           |
| MATERIAL       | Contact material   | _  | 'neutral'   |
| NAME           | Electrode name   |    | 'anode'     |
| OXCHARGE       | Oxide charge   |    | 0           |
| OXIDEBNDRYFLAG | Oxide layer boolean  |    | false       |
| OXTHICK        | Oxide thickness  |    | 0           |
| SIDE           | Side specification (top, bottom, left or right)                |    | 'top'       |
| START          | Starting location  |    | 0           |

### **Electrode Parameters 2D**

**Doping or Region Parameters** The DOPINGPROFILES and REGION parameters are synonyms, therefore their tables of values are identical. The use of both parameters in the same device instance could lead to unpredictable behavior.

Table 2-173. DOPINGPROFILES Composite Parameters

| Parameter  | Description  |                    | Default   |
|------------|--|--------------------|-----------|
| EL2        |  | _                  | 0         |
| EXPRESSION | User-defined expressions for dopant profiles as function of depth          |                    | 'none'    |
| FILE       |  | _                  | 'none'    |
| FLATX      | Determines the doping shape (half-gaussian or a full gaussian)             | _                  | 0         |
| FLATY      | 2D ONLY: Determines the doping shape (half-gaussian or a full gaussian)    |                    | 0         |
| FUNCTION   | Functional form of doping region; options are uniform, gaussian, and step. |                    | 'uniform' |
| NAME       |  | _                  | 'none'    |
| NMAX       | Maximum value of impurity concentration                                    | $\mathrm{cm}^{-3}$ | 1e+15     |
| NMAXCHOP   |  | $\mathrm{cm}^{-3}$ | 1e+20     |
| NMIN       | Minimum value of impurity concentration                                    | $\mathrm{cm}^{-3}$ | 0         |
| SPECIES    |  |                    | 'none'    |
| TYPE       | ntype or ptype   |                    | 'ntype'   |
| XLOC       | Peak location of the doping in the x-direction                             |                    | 0         |
| XMAX       |  | cm                 | 0         |
| XMIN       |  | cm                 | 0         |

Table 2-173. DOPINGPROFILES Composite Parameters

| Parameter | Description  |    | Default |
|-----------|--|----|---------|
| XWIDTH    | Distance from nmax to nmin. This is only applicable for the function=gaussian case.          | cm | 0.001   |
| YLOC      | 2D ONLY: Peak location of the doping in the y-direction ()                                   | cm | 0       |
| YMAX      | 2D ONLY:   | cm | 0       |
| YMIN      | 2D ONLY:   | cm | 0       |
| YWIDTH    | 2D ONLY: Distance from nmax to nmin. This is only applicable for the function=gaussian case. | cm | 0.001   |

**Table 2-174. REGION Composite Parameters** 

| Parameter Description |  | Units              | Default   |
|-----------------------|--|--------------------|-----------|
| EL2                   |  | _                  | 0         |
| EXPRESSION            |  | _                  | 'none'    |
| FILE                  |  | _                  | 'none'    |
| FLATX                 | Determines the doping shape (half-gaussian or a full gaussian)                               | _                  | 0         |
| FLATY                 | 2D ONLY: Determines the doping shape (half-gaussian or a full gaussian)                      | _                  | 0         |
| FUNCTION              | Functional form of doping region; options are uniform, gaussian, and step.                   | _                  | 'uniform' |
| NAME                  |  | _                  | 'none'    |
| NMAX                  | Maximum value of impurity concentration  | $\mathrm{cm}^{-3}$ | 1e+15     |
| NMAXCHOP              |  | $\mathrm{cm}^{-3}$ | 1e+20     |
| NMIN                  | Minimum value of impurity concentration  | $\mathrm{cm}^{-3}$ | 0         |
| SPECIES               |  | _                  | 'none'    |
| TYPE                  | ntype or ptype   | _                  | 'ntype'   |
| XLOC                  | Peak location of the doping in the x-direction   | cm                 | 0         |
| XMAX                  |  | cm                 | 0         |
| XMIN                  |  | cm                 | 0         |
| XWIDTH                | Distance from nmax to nmin. This is only applicable for the function=gaussian case.          | cm                 | 0.001     |
| YLOC                  | 2D ONLY: Peak location of the doping in the y-direction ()                                   |                    | 0         |
| YMAX                  | 2D ONLY:   |                    | 0         |
| YMIN                  | 2D ONLY:   |                    | 0         |
| YWIDTH                | 2D ONLY: Distance from nmax to nmin. This is only applicable for the function=gaussian case. |                    | 0.001     |

Table 2-175. Description of the flatx, flaty doping parameters

| Flatx or Flaty<br>view | Description   | 1D Cross Section |
|------------------------|---|------------------|
| 0                      | Gaussian on both sides of the peak (xloc) location.   |                  |
| +1                     | Gaussian if x>xloc, flat (constant at the peak value) if x <xloc.< td=""><td></td></xloc.<>       |                  |
| -1                     | Gaussian if x <xloc, (constant="" at="" flat="" if="" peak="" the="" value)="" x="">xloc.</xloc,> |                  |

# **Flat Parameters**

### 2.4.1. Physical Models

This section contains information about physical models used in Xyce for TCAD devices. This includes various mobility models, expressions for calculating the effective mass for electrons and holes, an expression for intrinsic carrier concentration as a function of temperature, expressions which describe contacts to metal as well as contacts to metal-oxide-semiconductor devices.

### 2.4.1.1. Material Models and Parameters

This section describes some of the basic material properties that are available in Xyce. Described here are the models for effective mass, intrinsic carrier concentration, and the bandgap. This information is needed for the more complex models described in the mobility section (section 2.4.2) and the boundary condition section (section 2.4.2.6).

#### 2.4.1.2. Effective Mass

Xyce includes functions which return the effective mass of electrons and holes for a number of semiconductor materials.

### 2.4.1.3. Electron Effective Mass

The electron effective mass is calculated as

$$m_{de} = (m_l^* m_t^{*2})^{1/3} (2.61)$$

where  $m_l$  and  $m_t$  are the effective masses along the longitudinal and transverse directions of the ellipsoidal energy surface.

### 2.4.1.4. Hole Effective Mass

The hole effective mass is calculated as

$$m_{dh} = (m_{lh}^{*3/2} + m_{hh}^{*3/2})^{2/3} (2.62)$$

where  $m_{lh}$  and  $m_{hh}$  are the "light" and "heavy" hole masses, respectively.

#### 2.4.1.5. Intrinsic Carrier Concentration

The intrinsic carrier concentration in a semiconductor is obtained from the "np" product

$$np = n_i^2 = N_C N_V exp(-E_g/kT)$$
 (2.63)

or

$$n_i = \sqrt{N_C N_V} e^{-E_g/2kT} \tag{2.64}$$

The expression used in Xyce to calculate the intrinsic carrier concentration comes from this and is given by

$$n_i = 4.9 \times 10^{15} \left(\frac{m_{de} m_{dh}}{m_0^2}\right)^{3/4} M_c^{1/2} T^{3/2} e^{-E_g/2kT}$$
(2.65)

where  $M_c$  is the number of equivalent minima in the conduction band for the semiconductor,  $m_{de}$  is the density-of-state effective mass for electrons,  $m_{dh}$  is the density-of-state effective mass for holes, and  $m_0$  is the free-electron mass.

 $n_i$  at room Semiconductor **Symbol** temperature  $1.25x10^{10}$ Silicon  $\sqrt{6.00}$ si  $2.5x10^{13}$ Germanium 2.00 ge Galium Arsenide 1.00  $2.0x10^{6}$ gaas

**Table 2-176. Intrinsic Carrier Concentration Parameters** 

### 2.4.1.6. Bandgap

The bandgap is a material and temperature-dependent quantity. The bandgap model for semiconductor materials, is based on Thurmond [43]. This model is given by:

$$E_g = E_{g0} - A * \left(\frac{T^{2.0}}{T + T_{off}}\right)$$
 (2.66)

where  $E_g$  is the bandgap (eV) and T is the temperature (K). A,  $E_{g0}$ , and  $T_{off}$  are all material-dependent constants. Insulating materials, such as silicon dioxide, are assumed to have constant bandgaps, so their bandgaps are given by:

$$E_g = E_{g0} \tag{2.67}$$

where  $E_{g0}$  is a material-dependent constant. The values for the material-dependent constants used by equations 2.66 and 2.67 are given in Table 2-177.

Table 2-177. Bandgap constants

| Material        | Symbol | $E_{g0}$ (eV) | A        | $T_{off}$ ( <b>K</b> ) |
|-----------------|--------|---------------|----------|------------------------|
| Silicon         | si     | 1.17          | 4.73e-4  | 636.0                  |
| Germanium       | ge     | 0.7437        | 4.774e-4 | 235.0                  |
| Galium Arsenide | gaas   | 1.519         | 5.405e-4 | 204.0                  |
| Silicon Dioxide | sio2   | 9.00          | NA       | NA                     |
| Silicon Nitride | wdi    | 4.7           | NA       | NA                     |
| Sapphire        | cu     | 4.7           | NA       | NA                     |

### 2.4.2. Mobility Models

A number of mobility models are included in Xyce. The analytic, arora, and carrier-carrier scattering models are considered to be low-field mobility models. The Lombardi surface mobility model is a transverse-field dependent model which also incorporates the mobility of the bulk silicon.

### 2.4.2.1. Analytic Mobility

This is a concentration- and temperature-dependent empirical mobility model, based on the work of Caughey and Thomas [44], which combines the effects of lattice scattering and ionized impurity scattering. The equation for the mobility of electrons is:

$$\mu_{0n} = \mu_{nmin} + \frac{\mu_{nmax} (\frac{T}{T_{ref}})^{nun} - \mu_{nmin}}{1 + (\frac{T}{T_{ref}})^{xin} (N_{total}/N_n^{ref})^{\alpha_n}}$$
(2.68)

and the equation for the mobility of holes is:

$$\mu_{0p} = \mu_{pmin} + \frac{\mu_{pmax} (\frac{T}{T_{ref}})^{nup} - \mu_{pmin}}{1 + (\frac{T}{T_{ref}})^{xip} (N_{total}/N_p^{ref})^{\alpha_p}}$$
(2.69)

where  $N_{total}$  is the local total impurity concentration (in  $\#/cm^3$ ),  $T_{ref}$  is a reference temperature (300.15K), and T is the temperature (in degrees K). The parameters  $N_n^{ref}$  and  $N_p^{ref}$  are reference values for the doping concentration. The analytic mobility model can be selected by using the statement "mobmodel=analytic" in the netlist.

The parameters for the analytic mobility model are given in Table 2-178.

Table 2-178. Analytic Mobility Parameters

| Parameter    | Silicon  | GaAs    |
|--------------|----------|---------|
| $\mu_{nmin}$ | 55.24    | 0.0     |
| $\mu_{nmax}$ | 1429.23  | 8500.0  |
| $N_n^{ref}$  | 1.072e17 | 1.69e17 |
| nun          | -2.3     | -1.0    |
| xin          | -3.8     | 0.0     |
| $\alpha_n$   | 0.73     | 0.436   |
| $\mu_{pmin}$ | 49.70    | 0.0     |
| $\mu_{pmax}$ | 479.37   | 400.0   |
| $N_p^{ref}$  | 1.606e17 | 2.75e17 |
| nup          | -2.2     | -2.1    |
| xip          | -3.7     | 0.0     |
| $\alpha_p$   | 0.70     | 0.395   |
|              |          |         |

### 2.4.2.2. Arora Mobility

This mobility model is also an analytic model which depends on impurity concentration and temperature. It comes from the work of Arora, *et al.* [45] and is based on both experimental data and the modified Brooks-Herring theory of mobility. The equation for the mobility of electrons is:

$$\mu_{0n} = \mu_{n1} \left(\frac{T}{T_{ref}}\right)^{exn1} + \frac{\mu_{n2} \left(\frac{T}{T_{ref}}\right)^{exn2}}{1 + \left(\frac{N_{total}}{C_{n}\left(\frac{T}{T_{ref}}\right)^{exn3}}\right)^{\alpha_{n}}}$$
(2.70)

and the equation for the mobility of holes is:

$$\mu_{0p} = \mu_{p1} \left(\frac{T}{T_{ref}}\right)^{exp1} + \frac{\mu_{p2} \left(\frac{T}{T_{ref}}\right)^{exp2}}{1 + \left(\frac{N_{total}}{Cp\left(\frac{T}{T_{ref}}\right)^{exp3}}\right)\alpha_{p}}$$
(2.71)

where

$$\alpha_n = An(\frac{T}{T_{ref}})^{exn4} \tag{2.72}$$

and

$$\alpha_p = Ap(\frac{T}{T_{ref}})^{exp4} \tag{2.73}$$

The Arora mobility model can be selected by including the statement "mobmodel=arora" in the netlist. The parameters for the arora mobility model are given in Table 2-179.

Table 2-179. Arora Mobility Parameters

| Parameter  | Silicon | GaAs    |  |
|------------|---------|---------|--|
| $\mu_{n1}$ | 88.0    | 8.5e3   |  |
| $\mu_{n2}$ | 1252.0  | 0.0     |  |
| Cn         | 1.26e17 | 1.26e17 |  |
| An         | 0.88    | 0.0     |  |
| exn1       | -0.57   | -0.57   |  |
| exn2       | -2.33   | 0.0     |  |
| exn3       | 2.4     | 0.0     |  |
| exn4       | -0.146  | 0.0     |  |
| $\mu_{p1}$ | 54.3    | 4e2     |  |
| $\mu_{p2}$ | 407.0   | 0.0     |  |
| Ср         | 2.35e17 | 2.35e17 |  |
| Ap         | 0.88    | 0.0     |  |
| exp1       | -0.57   | 0.0     |  |
| exp2       | -2.23   | 0.0     |  |
| exp3       | 2.4     | 0.0     |  |
| exp4       | -0.146  | 0.0     |  |
|            |         | ,       |  |

### 2.4.2.3. Carrier-Carrier Scattering Mobility

This mobility model is based on the work of Dorkel and Leturq [46]. It incorporates carrier-carrier scattering effects, which are important when high concentrations of electrons and holes are present in the device. This model also takes lattice scattering and ionized impurity scattering into account. One important difference between the carrier-carrier scattering mobility model and the two previous mobility models (analytic and arora models) is that the carrier-carrier scattering mobility model depends upon the actual carrier concentrations in the device. This model is important for modeling breakdown as well as various radiation effects, which often result in very high carrier densities.

The expressions for the carrier-carrier model are as follows:

$$\mu_L = \mu_{L0} (\frac{T}{T_{ref}})^{-\alpha} \tag{2.74}$$

where  $\mu_L$  is the lattice mobility, which has to do with scattering due to acoustic phonons.

$$\mu_I = \frac{AT^{3/2}}{N} \left[ ln(1 + \frac{BT^2}{N}) - \frac{BT^2}{N + BT^2} \right]^{-1}$$
 (2.75)

where  $\mu_I$  is the impurity mobility which is related to the interactions between the carriers and the ionized impurities.

$$\mu_{ccs} = \frac{2 \times 10^{17} T^{3/2}}{\sqrt{pn}} [ln(1 + 8.28 \times 10^8 T^2 (pn)^{-1/3})]^{-1}$$
 (2.76)

where  $\mu_{ccs}$  is the carrier-carrier scattering mobility, which is very important when both types of carriers are at high concentration.

$$X = \sqrt{\frac{6\mu_L(\mu_I + \mu_{ccs})}{\mu_I \mu_{ccs}}}$$
 (2.77)

is an intermediate term and

$$\mu = \mu_L \left[ \frac{1.025}{1 + (X/1.68)^{1.43}} - 0.025 \right]$$
 (2.78)

is the carrier mobility. The carrier-carrier scattering mobility can be selected by including the statement "mobmobel=carr" in the netlist. The parameters for the carrier-carrier mobility model are given in Table 2-180.

Table 2-180. Carrier-Carrier Mobility Parameters

| Parameter | Carrier        | Silicon | GaAs    |  |
|-----------|----------------|---------|---------|--|
| Al        | $e^-$          | 1430.0  | 8.50e3  |  |
| Bl        | e <sup>-</sup> | -2.2    | 0.0     |  |
| Ai        | e <sup>-</sup> | 4.61e17 | 4.61e17 |  |
| Bi        | e <sup>-</sup> | 1.52e15 | 1.52e15 |  |
| Al        | $h^+$          | 495.0   | 4.0e2   |  |
| B1        | $h^+$          | -2.2    | 0.0     |  |
| Ai        | $h^+$          | 1.00e17 | 1.00e17 |  |
| Bi        | $h^+$          | 6.25e14 | 6.25e14 |  |
|           |                | ,       | ,       |  |

### 2.4.2.4. Lombardi Surface Mobility Model

This mobility model combines expressions for mobility at the semiconductor-oxide interface and in bulk silicon. It is based on the work of Lombardi *et al.* [47]. The overall mobility is found using Mathiessen's rule:

$$\frac{1}{\mu} = \frac{1}{\mu_{ac}} + \frac{1}{\mu_b} + \frac{1}{\mu_{sr}} \tag{2.79}$$

where  $\mu_{ac}$  is the carrier mobility due to scattering with surface acoustic phonons,  $\mu_b$  is the carrier mobility in bulk silicon, and  $\mu_{sr}$  is the carrier mobility limited by surface roughness scattering.

The Lombardi model is a more physics-based surface mobility model. It is a semi-empirical model for carrier mobility, and the expressions for the individual scattering mechanisms were extracted from experimental data taken in appropriate experimental conditions.

The expressions used in this model are given below:

$$\mu_{ac,n} = \frac{bn}{E_{\perp}} + \frac{cnN^{exn4}}{T(E_{\perp})^{1/3}}$$
 (2.80)

is the expression for electron mobility for acoustic phonon scattering,

$$\mu_{ac,p} = \frac{bp}{E_{\perp}} + \frac{cpN^{exp4}}{T(E_{\perp})^{1/3}}$$
 (2.81)

is the expression for hole mobility for acoustic phonon scattering,

$$\mu_{b,n} = \mu_{n0} + \frac{\mu_{max,n} - \mu_{n0}}{1 + (N/crn)^{exn1}} - \frac{\mu_{n1}}{1 + (csn/N)^{exn2}}$$
(2.82)

is the expression for bulk mobility for electrons, where

$$\mu_{max,n} = \mu_{n2} \left(\frac{T}{T_{ref}}\right)^{-exn3} \tag{2.83}$$

and

$$\mu_{b,p} = \mu_{p0} exp(-pc/N) + \frac{\mu_{max,p}}{1 + (N/crp)^{exp1}} - \frac{\mu_{p1}}{1 + (csp/N)^{exp2}}$$
(2.84)

is the expression for bulk mobility for holes, where

$$\mu_{max,p} = \mu_{p2} (\frac{T}{T_{ref}})^{-exp3} \tag{2.85}$$

The expression for electrons for surface roughness scattering is

$$\mu_{sr,n} = \left(\frac{dn}{E_{\perp}^{exn8}}\right) \tag{2.86}$$

and the expression for holes for surface roughness scattering is

$$\mu_{sr,p} = \left(\frac{dp}{E_{\perp}^{exp8}}\right) \tag{2.87}$$

The parameters for the lombardi surface mobility model are given in Table2-181.

Table 2-181. Lombardi Surface Mobility Parameters

| Parameter  | Silicon | GaAs    |  |
|------------|---------|---------|--|
| $\mu_{n0}$ | 52.2    | 0.0     |  |
| $\mu_{n1}$ | 43.4    | 0.0     |  |
| $\mu_{n2}$ | 1417.0  | 1e6     |  |
| crn        | 9.68e16 | 9.68e16 |  |
| csn        | 3.43e20 | 0.0     |  |
| bn         | 4.75e7  | 1e10    |  |
| cn         | 1.74e5  | 0.0     |  |
| dn         | 5.82e14 | 1e6     |  |
| exn1       | 0.680   | 0.0     |  |
| exn2       | 2.0     | 0.0     |  |
| exn3       | 2.5     | 0.0     |  |
| exn4       | 0.125   | 0.0     |  |
| exn8       | 2.0     | 0.0     |  |
| $\mu_{p0}$ | 44.9    | 0.0     |  |
| $\mu_{p1}$ | 29.0    | 0.0     |  |
| $\mu_{p2}$ | 470.5   | 1.0     |  |
| crp        | 2.23e17 | 2.23e17 |  |
| csp        | 6.1e20  | 0.0     |  |
| bp         | 9.93e6  | 1e10    |  |
| ср         | 8.84e5  | 0.0     |  |
| dp         | 2.05e14 | 1e6     |  |
| exp1       | 0.719   | 0.0     |  |
| exp2       | 2.0     | 0.0     |  |
| exp3       | 2.2     | 0.0     |  |
| exp4       | 0.0317  | 0.0     |  |
| exp8       | 2.0     | 0.0     |  |
| pc         | 9.23e16 | 0.0     |  |

## 2.4.2.5. Edge Mobilities

Mobility values are calculated along the edge connecting two nodes. In the case of the analytic, arora, and surface mobility models, the edge mobilities are calculated by taking the average of the mobilities at the two nodes. Then, the mobility along the edge connecting nodes 1 and 2 is:

$$\mu_{edge} = (\mu[1] + \mu[2])/2.0$$
 (2.88)

In the case of the carrier-carrier scattering mobility, the edge mobilities were calculated differently. The electron and hole concentrations were first calculated at the midpoint of the edge using a "product" average and then these values of "n" and "p" were used in the function to calculate the mobility at the midpoint of the edge. For example, if n[1] and n[2] are the electron concentrations at nodes 1 and 2, the electron concentration along the edge is given by:

$$n_{edge} = \sqrt{n[1] * n[2]} \tag{2.89}$$

Subsequently, the mobility at the midpoint of an edge is found by using the values of electron and hole concentration at the midpoint of the edge when calling the function which returns the mobility, calcMob().

$$\mu_{n.edge}^{carrier} = f(n_{edge}) \tag{2.90}$$

This method makes more sense, especially when the electron and hole concentrations vary by several orders of magnitude. Then it approximates taking the average of the logarithms.

### 2.4.2.6. Boundary Conditions for Electrode Contacts

This section describes various boundary conditions that need to be applied to the semiconductor boundary. Xyce is predominantly an analog circuit simulator, and the TCAD (PDE-based) device modeling that has been implemented in Xyce takes external circuit information as input. This input consists of voltages and currents which are applied as boundary conditions to the semiconductor domain.

The physical connection from the circuit to the device generally includes a variety of materials, including metals and oxides. Electrical differences between the semiconductor and the contact material can result in a potential barrier that must be included in the imposed voltage boundary condition.

There are three general types of contacts between the circuit and the TCAD device that are handled by Xyce. The first is the "neutral" contact, in which it is simply assumed that the electrode material does not impose any addition potential barrier to that of the Fermi level differences in the semiconductor. The second is the Schottky contact, in which the electrode is a specified metal, and a potential barrier is imposed to account for the workfunction difference between the metal and the semiconductor. The last type of contact is the metal-oxide-semiconductor contact, in which the workfunction difference, and the voltage drop across the oxide must be accounted for.

### 2.4.2.7. Neutral Contacts

A neutral contact refers to the case in which the contact is made to the semiconductor itself, and barrier heights due to material differences are not considered. This is the simplest type of contact in Xyce, and problems which use this type of contact are generally easier to solve, compared with other types of contacts. In this case, the boundary is given by

$$V_{bc} = V_{ckt} + V_{bi} \tag{2.91}$$

where  $V_{ckt}$  is the potential applied by the circuit and  $V_{bi}$  is the "built-in" potential of the semiconductor. For a p-type substrate, the built-in potential is given by

$$V_{bi} = -\frac{kT}{q} ln(\frac{N_A}{n_i}) \tag{2.92}$$

and for an n-type substrate, the built-in potential is given by

$$V_{bi} = \frac{kT}{q} ln(\frac{N_D}{n_i}) \tag{2.93}$$

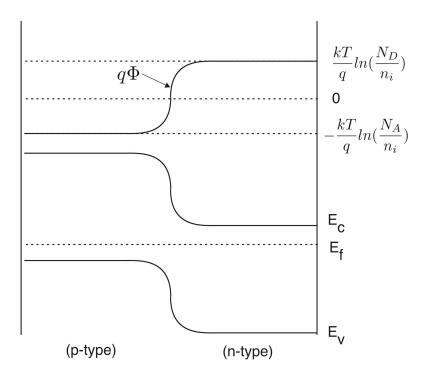


Figure 2-7. Neutral Contacts.

 $V_{bi}$  represents the extent of the energy band bending due to the doping of a device. While most of the dramatic changes will happen away from the contact, near junctions, it is still incorporated into the voltage boundary condition to maintain a flat potential near the contacts. Figure 2-7 shows the energy band variation across a PN junction, and the corresponding electrostatic potential. This variation is due to the internal physics of the device, and needs to be there even in the event of zero applied voltage. This is partially enforced by the solution to Poisson's equation, and also by the application of equation 2.91.

### 2.4.2.8. Schottky Contacts

In the case of a metal-semiconductor contact, it is necessary to add the workfunction difference,  $\Phi_{ms}$ , to the potential in the semiconductor [48].  $\Phi_m$  is a constant for a given metal, and  $\Phi_s$  is a function of the doping in the semiconductor. The workfunction potential,  $\Phi$ , when multiplied by q, is the difference between the Fermi level and vacuum in the material. In essence, the workfunction difference represents the distance

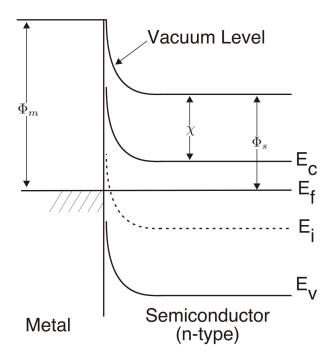


Figure 2-8. Schottky Contact, N-type.

between the Fermi level in the metal and the Fermi level in the semiconductor when considering the individual band structures.

In the case of an n-type semiconductor, the semiconductor workfunction can be represented as

$$\Phi_{s} = \chi + (E_C - E_{FS})/q \tag{2.94}$$

where  $\chi$  is the electron affinity in the semiconductor and  $q\chi$  is the distance between the conduction band and vacuum in the semiconductor.  $E_C$  is the conduction band energy and  $E_{FS}$  is the Fermi level of the semiconductor. Rewriting this expression in terms of the doping concentration, it becomes

$$\Phi_s = \chi + E_g/2 - V_t ln(\frac{N_d}{n_i})$$
(2.95)

In the case of a p-type semiconductor, the semiconductor workfunction can be represented as

$$\Phi_{s} = \chi + E_{o}/2 + (E_{i} - E_{FS})/q \tag{2.96}$$

where  $E_i$  is the intrinsic value of the Fermi level, and can be approximated as the halfway point between the conduction band  $(E_C)$  and the valance band  $(E_V)$ . Rewriting this expression in terms of the doping concentration

$$\Phi_s = \chi + E_g/2 + V_t ln(\frac{N_a}{n_i})$$
 (2.97)

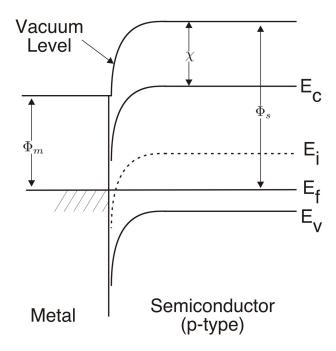


Figure 2-9. Schottky Contact, P-type.

For the TCAD devices in Xyce, for a node at a metal-semiconductor contact, the quantity  $\Phi_m - \Phi_s$  is added to the potential at the node to account for the metal-semiconductor barrier. The current values of metal workfunctions used in Xyce are given in Table 2-182. The values for electron affinity are given in Table 2-183. The boundary condition for a metal electrode in Xyce is given by

$$V_{bc} = V_{ckt} + V_{bi} + \Phi_{ms} \tag{2.98}$$

where  $V_{ckt}$  is the potential applied by the circuit to the electrode and  $V_{bi}$  is the "built-in" potential of the semiconductor, a function of the semiconductor doping.

Table 2-182. Material workfunction values

| Metal                 | Symbol | <b>Workfunction,</b> $\Phi_m$ (Volts) |
|-----------------------|--------|---------------------------------------|
| aluminum              | al     | 4.10                                  |
| p+-polysilicon        | ppoly  | 5.25                                  |
| n+-polysilicon        | npoly  | 4.17                                  |
| molybdenum            | mo     | 4.53                                  |
| tungsten              | W      | 4.63                                  |
| molybdenum disilicide | modi   | 4.80                                  |
| tungsten disilicide   | wdi    | 4.80                                  |
| copper                | cu     | 4.25                                  |
| platinum              | pt     | 5.30                                  |
| gold                  | au     | 4.80                                  |

Table 2-183. Electron affinities

| Semiconductor   | Symbol   | Electron Affinity, $\chi$ (Volts) |
|-----------------|----------|-----------------------------------|
| Silicon         | si       | 4.17                              |
| Germanium       | ge       | 4.00                              |
| Galium Arsenide | gaas     | 4.07                              |
| Silicon Dioxide | sio2     | 0.97                              |
| Nitride         | nitride  | 0.97                              |
| Sapphire        | sapphire | 0.97                              |

#### 2.4.2.9. Metal-Oxide-Semiconductor Contacts

To date in Xyce, only semiconductor material is included in the PDE solution domain. Metals and oxide materials are only included through boundary conditions. This is an adequate approach for a lot of problems. For some problems (such as modeling of low-dose radiation effects) modeling the oxide in more detail, as a PDE, will become necessary. However, since oxides are usually very thin, compared with the semiconductor domain, meshing both materials as part of the same simulation is difficult. Therefore, incorporating the effects of a gate oxide as part of the gate boundary condition is a reasonable approach.

In the case of a contact to a metal-oxide-semiconductor structure, the separation of the Fermi energies in the metal and the semiconductor at equilibrium is due to two effects: the workfunction difference between the metal and the semiconductor, and the effective interface charge. These two effects cause the bands to bend at the surface in equilibrium. The flatband voltage is the sum of these two terms [48]:

$$V_{FB} = \Phi_{ms} - \frac{Q_i}{C_i} \tag{2.99}$$

where  $\Phi_{ms}$  is the metal-semiconductor workfunction difference,  $Q_i$  is the value of interface charge (in  $C/cm^2$ ), and  $C_i$  is the oxide capacitance per unit area, which is given by

$$C_i = \frac{\varepsilon_{ox}\varepsilon_0}{x_o} \tag{2.100}$$

The voltage  $V_{FB}$  is the amount of bias which, when applied to the gate, causes the electron energy bands to be flat. This is the potential that is added to a boundary node in Xyce to account for a metal-oxide-semiconductor barrier. The overall boundary condition for a contact to a metal-oxide-semiconductor structure is given by

$$V_{bc} = V_{ckt} + V_{bi} + \Phi_{ms} - Q_i / C_i \tag{2.101}$$

where  $V_{ckt}$  is the potential applied by the circuit and  $V_{bi}$  is the "built-in" potential of the semiconductor.

#### 2.4.2.10. NMOS Device

The default NMOS device used in Xyce has a substrate doping concentration of  $1.0 \times 10^{16}/cm^3$  and an oxide thickness of  $1.0 \times 10^{-6}cm$ . Since the ideal threshold voltage  $V_T$  is given by

$$V_T = 2\phi_F + \frac{\varepsilon_s}{\varepsilon_{ox}} x_o \sqrt{\frac{2qN_A\phi_F}{\varepsilon_s \varepsilon_0}}$$
 (2.102)

 $V_T$  is equal to 0.892 V. for this device. Note that

$$\phi_F = \frac{1}{q} [E_i(bulk) - E_F] = \frac{kT}{q} ln(\frac{N_A}{n_i})$$
 (2.103)

for a p-type semiconductor substrate and

$$\phi_F = -\frac{kT}{q} ln(\frac{N_D}{n_i}) \tag{2.104}$$

for an n-type substrate.

# 3. COMMAND LINE ARGUMENTS

Xyce supports a handful of command line arguments which must be given *before* the netlist filename. While most of these are intended for general use, others simply give access to new features that, while supported, are not enabled by default. The general usage is as follows:

Xyce [arguments] <netlist filename>

Table 3-1 gives a list of supported command line options.<sup>1</sup>

Table 3-1. List of Xyce command line arguments.

| Table 3-1. List of Ayce command line arguments. |   |  |   |
|---|---|--|---|
| Argument  | Description   | Usage  | Default   |
| -h  | Help option. Prints usage and exits.  | -h   | -   |
| -V  | Prints the version banner and exits.  | -A   | -   |
| -license  | Prints the license text and exits.  | -license   | -   |
| -capabilities                                   | Prints a list of compiled-in options and exits.   | -capabilities  | -   |
| -delim  | Set the output file field delimiter.  | -delim<br><tab comma string></tab comma string>                    | -   |
| -0  | Place the output result(s) into file(s) with the specified basename and the appropriate extension (e.g.,<br><br><br><br><br>                                      | -o <basename></basename>   | output file<br>name(s) based on<br>netlist file name. |
| -1  | Place the log output into specified file.   | -l <file></file>   | Log output sent to standard out.                      |
| -r  | Output a binary rawfile.  | -r <file></file>   | No rawfile written.                                   |
| -a  | Use with -r to output a readable (ASCII) rawfile. Without the concurrent use of -r, -a will cause all .PRINT lines that use FORMAT=RAW to produce ASCII rawfiles. | -r <file> -a<br/>-a</file>   | Default rawfile is binary.                            |
| -nox  | Use the NOX nonlinear solver.   | -nox <on off></on off>   | on  |
| -linsolv  | Set the linear solver.  | -linsolv <klu <br>KSPARSE SUPERLU <br/>AZTECOO BELOS&gt;</klu <br> | KLU(serial) and<br>AztecOO(parallel)                  |
| -param  | Print a terse summary of model and/or device parameters, and default values.  | -param   | -   |

<sup>&</sup>lt;sup>1</sup>Note that the "-h" option might list command line options not present in this table. These extra options are generally deprecated and should not be used. Only the options listed in the table are considered supported features.

Table 3-1. List of Xyce command line arguments.

| Argument          | Description  | Usage   | Default   |
|-------------------|--|---|---|
| -prf              | Specify a file with simulation parameters.   | -prf <filename></filename>  | -   |
| -rsf              | Specify a file to save simulation responses functions.   | -rsf <filename></filename>  | -   |
| -remeasure        | Recompute .measure and/or .fft results with existing data.   | -remeasure  | -   |
| -syntax           | Check netlist syntax then exit.  | -syntax   | -   |
| -norun            | Check netlist syntax and topology, then exit.  | -norun  | -   |
| -quiet            | Suppress some of the simulation-progress messages sent to stdout for transient simulations.                      | -quiet  | -   |
| -namesfile        | Output a list of all solution variables generated by the netlist into <filename></filename>                      | -namesfile<br><filename></filename>                                 | -   |
| -noise_names_file | Output a list of all noise sources for all devices generated by the netlist into <filename></filename>           | -noise_names_file<br><filename></filename>                          | -   |
| -randseed         | Set random number seed for expression library's random number functions and also . SAMPLING analysis             | -randseed <number></number>   | If not provided,<br>Xyce will<br>generate a seed<br>internally.                             |
| -maxord           | Maximum time integration order.  | -maxord <15>  | -   |
| -jacobian_test    | Jacobian matrix diagnostic.  | -jacobian_test  | -   |
| -hspice-ext       | Hspice parser extensions. This will override several parser issues that are difficult to translate with scripts. | -hspice-ext<br><all separator<br> units math&gt;</all separator<br> | The second argument will determine which features are enabled. For details see section 3.1. |

A few other command line options are available that are typically only used in Xyce development. For example the options <code>-param</code>, <code>-info</code>, <code>-doc</code> and <code>-doc\_cat</code> are used to generate the device tables in this guide. The options <code>-jacobian\_test</code> and <code>-namesfile</code> can be useful in debugging new devices in Xyce. The option <code>-namesfile</code> is also useful for determining the "fully qualified node names", including the subcircuit hierarchy, for nodes and internal variables for mutual inductors. The <code>.PRINT</code> section 2.1.31 has more information on, and examples for, the <code>-namesfile</code> command line option.

# 3.1. Hspice extensions

The command line argument <code>-hspice-ext</code> is more complicated than most, so its explanation is given in this section. The second argument to <code>-hspice-ext</code> can either be a single string or can be a comma separated list.

- Using all will enable all the features.
- Using units sets the use of the "atto" prefix, designated by "a", to mean a mutliplier of "1E-18". Without this setting, the "a" prefix means units of amperes.
- Using math sets the use of Hspice style math operators. Most importantly, it forces "log" to mean the natural logarithm, rather than the base 10 logarithm.
- Using separator sets the use of the period "." for subcircuit name separation. If this is not set, the colon ":" is used instead.

#### 4. RUNTIME ENVIRONMENT

# 4.1. Running Xyce in Serial

After ensuring that the directory into which Xyce was installed is in your PATH variable, one merely executes the code by running the command, Xyce with the desired netlist name appended.

### 4.2. Running Xyce in Parallel

Open MPI must be installed on the host machine. It may be download from

http://www.open-mpi.org/. Consult the documentation for help with installation.

After ensuring that the both the directory into which Xyce was installed and the directory in which mpirun is found are in your PATH variable, one merely executes the code by running the command, mpirun [mpirun options] Xyce [xyce options] with the desired netlist name appended.

# 4.3. Running Xyce on Sandia HPC and CEE Platforms

This version of Xyce has been installed centrally on Sandia HPC and CEE platforms, and requires metagroup access. Contact the Xyce team for details on how to obtain this access.

Once you have registered for metagroup membership, the central installs of Xyce may be accessed by a module load.

module load Xyce adds all required modules and sets all required environment variables to access the normal version of Xyce. module load XyceRad does the same thing for the version Xyce containing Sandia proprietary models.

module help Xyce provides some additional information about what the module does.

Consult the system documentation for help with submitting jobs on these platforms.

https://computing.sandia.gov/

## 5. SETTING CONVERGENCE PARAMETERS FOR XYCE

Because the solution algorithms and methods within Xyce are different than those used by other circuit simulation tools (e.g., SPICE), the overall convergence behavior is sometimes different, as are the parameters which control this behavior.

# 5.1. Adjusting Transient Analysis Error Tolerances

Xyce uses a variable order trapezoid integration as its default scheme, and this method may also be requested explicitly with the **TIMEINT** option METHOD=trap or METHOD=7. Trapezoid time-stepping is second order accurate and does not have any numerical dissipation in its local truncation error. Variable order trapezoid integration dynamically uses Backward Euler (BE) and trapezoid rule. When ERROPTION=1 is set with METHOD=7, trapezoid rule is used almost exclusively (BE only used at breakpoints). See table 2-4 for details.

Another time integration option is the second-order Gear method. It may be selected with the **TIMEINT** option METHOD=gear or METHOD=8. See table 2-4 for details.

#### 5.1.1. Setting RELTOL and ABSTOL

In Xyce, both the time integration package and the nonlinear solver package have **RELTOL** and **ABSTOL** settings. Some general guidelines for settings parameters are [49]:

- Use the same RELTOL and ABSTOL values for both the TIMEINT and the NONLIN-TRAN .OPTIONS statements.
- For a conservative approach (i.e., safe), set RELTOL=1.0E-(m+1) where m is the desired number of significant digits of accuracy.
- Set **ABSTOL** to the smallest value at which the solution components (either voltage or current) are essentially insignificant.
- Note that the above suggests that **ABSTOL** < **RELTOL**.

The current defaults for these parameters are ABSTOL=1.0E-6 and RELTOL = 1.0E-3. For a complete list of the time integration parameters, see chapter 2.1.

# 5.2. Adjusting Nonlinear Solver Parameters (in transient mode)

In Xyce, the nonlinear solver options for transient analysis are set using the .OPTIONS NONLIN-TRAN line in a netlist. This subsection gives some guidelines for setting this parameters.

- For guidelines on setting **RELTOL** and **ABSTOL**, see above.
- **RHSTOL** This is the maximum residual error for each nonlinear solution. Xyce uses this as a "safety" check on nonlinear convergence. Typically, 1.0E-2 (the default) works well.
- **DELTAXTOL** This is the weighted update norm tolerance and is the primary check for nonlinear convergence. Since it is weighted (i.e., normalized using **RELTOL** and **ABSTOL**), a value of 1.0 would give it the same accuracy as the time integrator. For robustness, the default is 0.33 but sometimes a value of 0.1 may help prevent "time-step too small" errors. A value of 0.01 is considered quite small.
- MAXSTEP This is the maximum number of Newton (nonlinear) steps for each nonlinear solve. In transient analysis, the default is 20 but can be increased to help prevent "time-step too small" errors. This is roughly equivalent to ITL4 in SPICE.

# 6. QUICK REFERENCE FOR USERS OF OTHER SPICE CIRCUIT SIMULATORS

This chapter describes many of the differences between Xyce and other SPICE-like circuit simulaters. The primary focus is on the difference between Orcad PSpice and Xyce, with an eye towards providing the ability for those familiar with using PSpice to begin using Xyce quickly. PSpice compatibility was an early focus for the Xyce project.

The Xyce team also supports a netlist translation tool, XDM (for Xyce Data Model) [50]. This tool supports translation of netlists in Pspice, Hspice and Spectre format into Xyce formatted netlist files. There is also a Xyce command line option (-hspice-ext all) which is designed to assist with a handful of Hspice syntax issues that are particularly difficult to translate.

This chapter is likely not complete, and Xyce users might also consult specific sections of this Reference Guide about particular Xyce commands. Those sections may have additional information on Xyce's incompatibilities with other circuit simulators, and how to work around them.

# 6.1. Differences Between Xyce and PSpice

This section is focused on the differences between Xyce and PSpice. However, some of this discussion also applies to other SPICE-like circuit simulators.

# 6.1.1. Command Line Options

Command line arguments are supported in Xyce but they are different than those of PSpice. For a complete reference, see Chapter 3.

#### 6.1.2. Device Support

Most, but not all, devices commonly found in other circuit simulation tools are supported. Xyce also contains enhanced versions of many semiconductor devices that simulate various environmental effects. For the complete list, please see the Analog Device Summary in Table 2-34.

### 6.1.3. OPTIONS Support

For the specific devices or models that are supported in Xyce, most of the standard netlist inputs are the same as those in standard SPICE. However, the **.OPTIONS** command has several additional features used to expose capabilities specific to Xyce. In particular, Xyce does not support the standard PSpice format **.OPTIONS** line in netlists. Instead, options for each supported package are called according to the following format.

# **Arguments and Options**

DEVICE

Device Model

TIMEINT

Time Integration

NONLIN

Nonlinear Solver

NONLIN-TRAN

Transient Nonlinear Solver

NONLIN-HB

**HB Nonlinear Solver** 

LOCA

Continuation/Bifurcation Tracking

LINSOL

Linear Solver

LINSOL-HB

**HB** Linear Solver

OUTPUT

Output

RESTART

Restart

HBINT

Harmonic Balance (HB)

SENSITIVITY

Direct and Adjoint sensitivity analysis

For a complete description of the supported options in Xyce, see section 2.1.25.

Known caveats are that the ABSTOL options have different definitions in PSpice and Xyce. Also, a PSpice .OPTIONS VNTOL=<value> line can be mapped into these two Xyce lines:

```
.OPTIONS NONLIN ABSTOL=<value>
.OPTIONS NONLIN_TRAN ABSTOL=<value>
```

The PSpice ITL1 and ITL4 options are similar to the Xyce MAXSTEPS. In PSpice, ITL1 affects .DC analyses, while ITL4 affects .TRAN analyses. In Xyce, .OPTIONS NONLIN refers to options for .DC analyses, while .OPTIONS NONLIN-TRAN refers to options for .TRAN analyses. So, a feasible mapping is PSpice .OPTIONS ITL1=20 becomes .OPTIONS NONLIN MAXSTEP=20 in Xyce. Similarly, PSpice .OPTIONS ITL4=20 becomes .OPTIONS NONLIN-TRAN MAXSTEP=20 in Xyce. However, given that PSpice and Xyce use different default values for ITL1 and ITL4 vs. MAXSTEPS, the best approach may be to not translate the ITL1 and ITL4 lines into the corresponding Xyce netlist.

### 6.1.4. .PROBE vs. .PRINT

Xyce does not support the ".**PROBE**" statement. Output of Probe-format files, in .csd format, that are readable by PSpice is done using the .**PRINT** netlist statement. See section 2.1.31 for the syntax for FORMAT=PROBE. That section also describes wildcard support and access to subcircuit nodes in Xyce, both of which are different than PSpice.

Xyce does not support PSpice style abbreviations in the **.PRINT** statement. For example, to print out the value of the voltage at node A in a transient simulation you must request .PRINT TRAN V(A), not .PRINT TRAN A. Xyce also does not support N() as a synonym for V() on .PRINT lines.

# 6.1.5. Converting PSpice ABM Models for Use in Xyce

Xyce is almost fully compatible with PSpice with respect to analog behavioral models. This includes the E, F, G, and H device types. A notable exception to this compatibility is in the use of lead and device currents in expressions used in controlled source definitions. That feature is not supported in Xyce. In addition, the FREQ, LAPLACE and CHEBYSHEV forms for E and E sources or the ERROR qualifier are not supported in Xyce..

### 6.1.6. Usage of STEP Analysis

The implementation of **.STEP** in Xyce is not the same as that of PSpice. See section 2.1.36 for the syntax and function of the **.STEP** function in Xyce.

### 6.1.6.1. Model Parameter Sweeps

PSpice requires extra keywords to apply a **.STEP** statement to a model parameter. Xyce handles model parameters differently, and is actually somewhat more flexible than PSpice. Unfortunately, this means that the two specifications are not compatible.

A model parameter in PSpice would be handled like this:

```
R1 1 2 RMOD 1
.model RMOD RES(R=30)
.step RES RMOD(R) 30 50 5
```

The equivalent way to specify this in Xyce would be:

```
R1 1 2 RMOD 1
.model RMOD RES(R=30)
.step RMOD:R 30 50 5
```

Note that Xyce does not require the RES keyword on the .STEP line. In PSpice, this keyword is needed to specify what type of model is being used. Xyce actually has more flexibility than PSpice in this regard—any model or instance variable can be set on the .STEP line using the same syntax.

```
Example: .step D101:IS 1.0e-3 5.0e-3 1.0e-3
```

In this example, D101 is the name of a model or instance, and IS is the name of the parameter within that model or instance.

# 6.1.7. Behavioral Digital Devices

There are at least four significant differences. First, the instance line syntax for the Xyce digital behavioral devices differs from PSpice. Second, Xyce uses one model card for the timing and Input/Output (I/O) characteristics, while PSpice uses separate model cards for timing and I/O characteristics. The model cards also have different parameters. Third, Xyce does support the DIGINITSTATE option. However, it has a different default value than in PSpice. So, the DCOP calculations for flip-flops and latches may be different in some cases between Xyce and PSpice. Finally, closely spaced input transitions to a gate (e.g., ones spaced by less than the DELAY parameter of the Xyce model) may produce different behaviors in Xyce and PSpice. Please consult Section 2.3.28 for more details.

#### 6.1.8. Power Dissipation

PSpice supports printing the power dissipation of a device via syntax like W (<name>). At this time, not all Xyce devices support power calculations. In addition, the Xyce results for the FET semiconductor devices (J, M and Z devices) may differ from the PSpice results. Consult the Features Supported by Xyce Device Models table in Section 2.3 and the individual sections on each device for more details. Additional limitations on lead current and power calculations in Xyce are given in Section 2.3.3.

Example work-arounds are as follows, using either the node voltage at Node 2 or the lead current through Resistor 2:

```
.DC V1 0 5 1
.param R2VAL=10
V1 1 0 5V
R1 1 2 10
R2 2 0 {R2VAL}
.PRINT DC V(2) {V(2) *V(2) /R2VAL} {I(R2) *I(R2) *R2VAL}
```

#### 6.1.9. Dependent Sources with TABLE Syntax

The documented PSpice syntax for the TABLE form of the E and G sources is identical to the Xyce syntax for those two devices. As an example, consider this E-source netlist line which conforms to the documented PSpice and Xyce syntaxes:

```
E5 5 0 TABLE V(1,0) = (-2,-3) (2,3)
```

There is an equal sign between the expression  $\{V(1,0)\}$  and the list of value pairs (e.g., before (-2,-3)). There is also a comma between the two values in each set of value pairs. However, it has been observed that some PSpice versions will accept variants of the documented PSpice syntax. As examples, PSpice might use this TABLE syntax, where the equal sign between the expression and the list of value pairs is missing and there is an extra set of parentheses around the list of value pairs:

```
TABLE {EXPR} ((x1,y1) (x2,y2) ... (xn, yn))
```

PSpice might also specify the TABLE syntax without the commas between the two values in each set of value-pairs. For example, this is a legal syntax in some PSpice versions:

```
TABLE \{EXPR\} = (x1 y1) (x2 y2) \dots (xn yn)
```

So, the generic solution is to change these alternative PSpice syntaxes (and possibly others) to conform with the Xyce E and G source TABLE syntax, which is (see also Sections 2.3.12 and 2.3.14):

```
TABLE \{EXPR\} = (x1, y1) (x2, y2) \dots (xn, yn)
```

#### 6.1.10. MODEL STATEMENTS

In PSpice, some . MODEL statements may have commas separating the list of parameters, which causes problems in Xyce. A simple workaround is to replace those commas with spaces in the corresponding Xyce. MODEL statements.

In PSpice, some . MODEL statements may not have parentheses surrounding the list of parameters. While Xyce also does not require parentheses in model cards, parentheses are accepted. The only Xyce requirement is that if they are used then they must be paired with one left parenthesis before all of the parameters and one right parentheses after all of the parameters. It is an error to have unmatched parentheses.

PSpice syntaxes where only a subset of the model parameters are enclosed within parentheses are also not supported in Xyce. A PSpice example is:

```
.model somebjt NPN Is=1e-16 (Xti=3 Bf=100) Eg=1.11 NC=2
```

Nested parentheses, as is often seen when a DEV (deviation) is specified for a parameter in a PSpice model statement, are also not allowed in Xyce. A PSpice example is:

```
.model someotherbjt NPN(Is=1e-16 Xti=3 (Bf=100 DEV=5%) Eq=1.11 NC=2)
```

The previous PSpice example also raises the issue of model parameters that are supported in PSpice but not in Xyce. It that case, Xyce will issue a warning about the invalid parameter and the simulation will run.

Another common issue is a PSpice model parameter (e.g., BV=) without a value. That PSpice syntax error is often silently ignored in PSpice, but flagged as a parsing error in a Xyce netlist.

Temperature coefficient (TC) specifications can be a problem also. The documented PSpice syntax is this, with a comma between the two values.

```
TC=0.1,0.1
```

However, it has been observed that some PSpice versions allow the TC parameter to omit the comma between those two values. That is not legal in Xyce.

#### 6.1.11. .NODESET and .IC Statements

Xyce and PSpice differ in their capabilities to handle .NODESET and .IC statements in subcircuits. See sections 2.1.22 and 2.1.14 for more details.

#### 6.1.12. Piecewise Linear Sources

The preferred Xyce syntax for PWL sources does not use parentheses or commas within the time-voltage pair listing. See Section 2.3.9 for more details.

The Xyce PWL source does not support the PSpice . IN format for file input. See Section 2.3.9 for the ASCII text and .csv formats supported by Xyce for file input.

The Xyce repeat R=<value> syntax for PWL sources is not compatible with the PSpice REPEAT syntax for PWL sources. Some work-arounds are as follows. This PSpice REPEAT FOREVER syntax:

```
VPWL1 1 0 PWL REPEAT FOREVER (0,0) (0.5,1) (1,0) + ENDREPEAT
```

is equivalent to this Xyce syntax:

```
VPWL1 1 0 PWL 0 0 0.5 1 1 0 R=0
```

Similarly, if the PSpice source has its time-voltage pairs in a .csv file, and the specified waveform starts at time=0, then this PSpice syntax:

```
VPWL2 2 0 PWL
+ REPEAT FOREVER
+ FILE "data.csv"
+ ENDREPEAT
```

is equivalent to this Xyce syntax:

```
VPWL2 2 0 PWL file "data.csv" R=0
```

For more general PSpice REPEAT syntaxes, and especially for the PSpice REPEAT for N syntax, the user might have to manually duplicate the PSpice waveform in a .csv file.

# 6.1.13. .AC Output

The Xyce .csd file format for a .AC analysis is different than the PSpice format, but is still viewable in the PSpice A/D waveform viewer. This PSpice .PROBE statement:

```
.PROBE/CSDF V([1b]) VR([1b]) VI([1b])
```

will produce #N and #C lines in its netlistName.csd file like this, where the real and imaginary parts of V(1b) are output for each data point on the #C line. The end-user can then use the PSpice A/D UI to choose to plot the VR and VI quantities.

```
#N
'V(1b)' 'V(1b)' 'V(1b)'
#C 1.0000000000E01 3
2.470E-02/-1.552E-01:1 2.470E-02/-1.552E-01:2 2.470E-02/-1.552E-01:3
```

This corresponding Xyce .PRINT AC statement:

```
.PRINT AC FORMAT=PROBE V(1b) VR(1b) VI(1b)
```

will produce #N and #C lines in its netlistName.csd file like this, where the real and imaginary parts of V(1b) are still output on the #C line. However, in Xyce, the VR() and VI() operators return real-valued quantities as shown below. This Xyce formatted file is still viewable in PSpice A/D.

```
#N
'V(1b)' 'VR(1b)' 'VI(1b)'
#C 1.0000000000E01 3
2.470e-02/-1.552e-01:1 2.470e-02/0.000e+00:2 -1.552e-01/0.000e+00:3
```

# 6.1.14. Additional differences

Some other differences between Xyce and PSpice are described in Table 6-1. Users should also consult Table 6-2, since that table lists more general incompatibilities that span multiple circuit simulators.

Table 6-1. Incompatibilities with PSpice.

| Issue  | Comment   |
|--|---|
| .VECTOR, .WATCH, and .PLOT output control analysis are not supported.              | Xyce does not support these commands.   |
| . PZ analysis is not supported.  | Xyce does not support this command.   |
| .DISTO analysis is not supported.  | Xyce does not support this command.   |
| . TF analysis is not supported.  | Xyce does not support this command.   |
| . AUTOCONVERGE is not supported.   | Xyce does not support this command.   |
| . SENS analysis is supported, but has a different syntax than PSpice.              | The Xyce version of .SENS requires that the user specify exactly which parameters are the subject of the sensitivity analysis. Additionally, Xyce can compute sensitivities in transient and .AC as well as the .DC case (unlike PSpice). |
| . NOISE analysis is supported, but not all devices supported.                      | The Xyce version of .NOISE is new enough that not all noise models have been implemented.   |
| .MC and .WCASE statistical analyses are not supported.                             | Xyce does not support these commands directly. However, Xyce does support a variety of UQ methods, including .SAMPLING, .EMBEDDEDSAMPLING and various polynomial chaos expansion methods.   |
| .DISTRIBUTION, which defines a user distribution for tolerances, is not supported. | Xyce does not support this command. This command goes along with .MC and .WCASE statistical analyses, which are also not directly supported.  |
| . LOADBIAS and . SAVEBIAS initial condition commands are not supported.            | Xyce does not support these commands.   |
| .ALIASES, .ENDALIASES, are not supported.  | Xyce does not support these commands.   |
| . STIMULUS is not supported.   | Xyce does not support this command.   |
| . TEXT is not supported.   | Xyce does not support this command.   |
| .PROBE does not work   | Xyce does not support this. Use the FORMAT=PROBE option of .PRINT instead. See section 2.1.31 for syntax.   |

| .OP only produces output in serial               | .OP is supported in Xyce, but will not produce the extra output normally associated with the .OP statement, if running a parallel build.  |
|--|---|
| Pulsed source rise time of zero                  | A requested pulsed source rise/fall time of zero really is zero in Xyce. In other simulators, requesting a zero rise/fall time causes them to use the printing interval found on the tran line.   |
| Mutual Inductor Model                            | Not the same as PSpice. This is a Sandia developed model.   |
| .PRINT line shorthand                            | Output variables have to be specified as a V(node) or I(source). Listing the node alone will not work.  |
| BSIM3 level                                      | In Xyce the BSIM3 level=9. In PSpice the BSIM3 is level=7.  |
| Interactive mode                                 | Xyce does not have an interactive mode.   |
| Time integrator default tolerances               | Xyce has much tighter default solver tolerances than some other simulators (e.g., PSpice), and thus often takes smaller time steps. As a result, it will often take a greater number of total time steps for a given time interval. To have Xyce take time steps comparable to those of PSpice, set the RELTOL and ABSTOL time integrator options to larger values (e.g., RELTOL=1.0E-2, ABSTOL=1.0E-6).  |
| .OPTIONS statements                              | Xyce does not support PSpice style .OPTION statements. In Xyce, the various packages all (potentially) have their own separate .OPTIONS line in the netlist. For a complete description, see section 2.1.25.  |
| DTMAX  | Xyce does support a maximum time step-size control on the .tran line, but we discourage its use. The time integration algorithms within Xyce use adaptive time-stepping methods that adjust the time-step size according to the activity in the analysis. If the simulator is not providing enough accuracy, the RELTOL and ABSTOL parameters should be decreased for both the time integration package (.OPTIONS TIMEINT) and the transient nonlinear solver package (.OPTIONS NONLIN-TRAN). We have found that in most cases specifying the same maximum timestep that PSpice requires for convergence actually slows Xyce down by preventing it from taking larger timesteps when the behavior warrants.                                 |
| .TRAN "UIC" keyword                              | PSpice requires the use of a keyword UIC on the .TRAN line in order to use initial conditions via IC keywords on instance lines. Doing so also tells PSpice not to perform an operating point calculation. In Xyce, UIC is ignored and produces a warning message. Xyce always uses initial conditions specified with IC keywords, and the case of inductors and capacitors automatically inserts a fictitious voltage source around the device that guarantees the correct potential drop across the device during the operating point. If the user desires that Xyce not perform an operating point calculation, but rather use an initial condition for a transient run of all zero voltages, then the user should specify NOOP instead. |
| Temperature specification                        | Device temperatures in Xyce are specified through the .OPTIONS DEVICE line. PSpice allows a .TEMP line that is not recognized (and is ignored) by Xyce.   |
| Lead currents for lossless<br>transmission lines | PSpice uses A and B to reference the two terminals of the lossless tranmission line. So, Xyce uses I1() and I2(), while PSpice uses IA() and IB() to access the lead currents for the device.   |
| Extended ASCII characters in . LIB files         | The use of those characters is fine in Xyce comment lines. It may be best to replace them with the printable equivalent on other Xyce netlist lines though.   |

# 6.1.15. Translating Between PSpice and Xyce Netlists

Some internal Sandia users have found the following checklist to be helpful in getting their PSpice netlists to run in Xyce. Additional changes may be needed in some cases.

#### For the .cir file:

- Change .LIB references to point to the modified libraries generated for use with Xyce.
- Change PROBE and PROBE 64 statements to PRINT <Sim Type>
- Find cases where the PSpice netlist used N() rather than V().
- .DC has the keyword PARAM in PSpice. If it exists then remove it in the Xyce netlist.
- .OPTIONS TNOM=X is changed to .OPTIONS DEVICE TNOM=X in the Xyce netlist.
- .TEMP args does not exist in Xyce. The equivalent Xyce statement is .STEP TEMP LIST args
- The default time integrator tolerances can make Xyce take smaller timesteps on some circuits, and therefore have slower simulation times. The Xyce timesteps can be increased at the expense of time integration accuracy by loosening the integrator tolerances. Some users find that .OPTIONS TIMEINT RELTOL=1e-2 ABSTOL=1e-4 leads to time steps more like PSpice's.
- Move any .IC and .NODESET statements to the top-level, and use the fully qualified node names in those statements.
- Adjust the syntax for any PWL sources, if needed, per Section 6.1.12.

#### For the .lib file:

- Add LEVEL=2 parameter to diode models.
- Fix the parentheses and comma differences between PSpice and Xyce.MODEL statements per Section 6.1.10.
- Find and modify any nested expression statements. This may entail replacing "{" with "(" in the expression in the Xyce netlist.
- Fix the table syntax for dependent sources, as discussed in Section 6.1.9.

# 6.2. Differences Between Xyce and Other SPICE Simulators

This section covers some known differences between Xyce and other SPICE-like circuit simulators, besides PSpice, as listed in Table 6-2. However, users of those other simulators (e.g., SPICE3F5, HSPICE, ngspice, ...) should also check the previous subsection on PSpice, since some of that discussion also applies here.

Table 6-2. Incompatibilities with Other Circuit Simulators.

| Table 6-2. Incompatibilities with Other Circuit Simulators.   |  |  |
|---|--|--|
| Issue   | Comment  |  |
| .DC sweep output.   | The .DC sweep calculation does not automatically output the sweep variable. Only variables explicitly listed on the .PRINT line are output.  |  |
| MOSFET levels.  | In Xyce the MOSFET levels are not the same. In Xyce, a BSIM3 is MOSFET level 9. Other simulators have different levels for the BSIM3.  |  |
| BSIM SOI v3.2 level.  | In Xyce the BSIM SOI (v3.2) is MOSFET level 10. Other simulators have different levels for the BSIM SOI.   |  |
| BSIM4 level.  | In Xyce the BSIM4 is MOSFET levels 14 and 54. Other simulators have different levels for the BSIM4.  |  |
| Syntax for .STEP is different.  | The manner of specifying a model parameter to be swept is slightly different than in some other simulators. See the Xyce Users' and Reference Guides for details.  |  |
| Switch is not the same as SPICE3F5.   | The Xyce switches are not compatible with the simple switch implementation in SPICE3F5. The switch in Xyce smoothly transitions between the ON and OFF resistances over a small range between the ON and OFF values of the control signal (voltage, current, or control expression). See the Xyce Reference Guide for the precise equations that are used to compute the switch resistance from the control signal values. The SPICE3F5 switch has a single switching threshold voltage or current, and RON is used above threshold while ROFF is used below threshold. Xyce's switch is considerably less likely to cause transient simulation failures. Results similar to SPICE3F5 can be obtained by setting VON and VOFF to the same threshold value, but this is not a recommended practice. |  |
| Piecewise Linear (PWL) source not fully compatible with either HSPICE or PSpice.  | See Sections 2.3.9 and 6.1.12 of the Xyce Reference Guide for more details.  |  |
| Acceptable prefixes in the metric system.   | The "atto" prefix, which is designated by "a", is acceptable in HSPICE, but is not accepted in Xyce. The use of the "atto" prefix in Xyce must be replaced with "E-18".  |  |
| Hierarchical parameters.  | In Xyce hierarchical parameters, M (multiplier or multiplicity factor) and S (scale), are not commonly supported. The M parameter is only supported by the R, L, C and MOSFET device models and some BJT device models (VBIC 1.3 and MEXTRAM).   |  |
| . MEASURE has some incompatibilities and differences with HSPICE.   | See Section 2.1.18.14 of the Xyce Reference Guide for more details.  |  |
| The P () accessor for power may give different results for semiconductor devices (D, J, M, Q and Z devices) and the lossless transmission device (T device) than with HSPICE. | See Sections 2.3.8, 2.3.18, 2.3.20, 2.3.17 2.3.25 and 2.3.19 for more details.   |  |
| The Xyce .OP statement provides less output than other simulators.  | See Section 2.1.24 for more details.   |  |

|   | T = ==================================  |
|---|---|
| Initial conditions for lossless and lossy transmission lines      | In SPICE3F5 and PSpice, initial conditions can be set on the initial voltages and currents at each end of the lossless transmission line, but not for the lossy transmission line. In Xyce, initial conditions can be set on the initial voltages and currents at each end of the lossy transmission line, but not for the lossless transmission line   |
| Use of vgs(Mxxx) style syntax on the .PRINT line                  | Some SPICE-style circuit simulators can use the .PRINT line to (for example) print out the vds, vgb, vsd, etc. values for a PMOS transistor (say, M1) using .PRINT TRAN vgs (M1) vbs (M1) vds (M1). This is not directly supported in Xyce. See Section 2.3.17 for how this is supported with the N() syntax for the BSIM3 and BSIM4 models. For other transistor devices, use something like this on the Xyce .PRINT line, V(ng, ns) where ng and ns are the names of the circuits nodes attached to the gate and source terminals of the transistor.  |
| Some devices do not work in frequency-domain analysis             | Devices that may be expected to work in AC or HB analysis do not at this time. For AC analysis this includes, but is not limited to, the lossy transmission line (LTRA) and lossless transmission line (TRA). The LTRA and TRA models will need to be replaced with lumped transmission line models (YTRANSLINE) to perform small-signal AC analysis. For harmonic balance, the two transmission line models do work correctly in frequency domain.  Independent behavioral sources, such as a time-dependent B, E, F, G, or H source, will not work correctly with either AC or HB. However, such sources which are purely dependent (only depending on solution variables and not time) will work in AC and HB. |
| The use of random expression operators like AGAUSS with sampling. | In Hspice, a parameter that is set to an a random operator, and then applied to multiple devices is either local or global, depending on the number of parameter layers. In Xyce, this is always treated as global.   |

# 6.3. DC Operating Point Calculation Failures in Xyce

This section discusses various netlist problems that can cause Xyce to fail to get a DC Operating Point (DCOP). Some of this discussion is "tutorial" in nature, but helps illustrate the issues.

# 6.3.1. Incompatible Voltage Constraints at Circuit Nodes

The Xyce DCOP calculation will fail if the netlist specifies incompatible voltage constraints at a given node in the circuit. This netlist fragment will cause Xyce to fail to get a DCOP because the two voltage sources obviously cannot both apply their assigned voltage at Node1.

```
VA Node1 0 1
VB Node1 0 2
```

This configuration is also not allowed because there is an infinite number of ways that the two voltage sources can supply current to the rest of the circuit and still maintain the requested voltage.

```
VA Node1 0 1
VB Node1 0 1
```

With those two netlist fragments as background, the next two examples illustrate a "Xyce-unique" way that DCOP failure can occur. This happens because initial conditions on capacitors in Xyce are enforced with additional voltage sources during the DCOP. So, these two netlist fragments are identical to the two cases given above, and will both cause a DCOP failure in Xyce. A similar problem can occur with other Xyce devices that allow initial conditions, for voltage drops across the device, to be set.

```
VA node1 0 1
CB node1 0 1.0pf IC=2

or

VA node1 0 1
CB node1 0 1.0pf IC=1
```

# 6.3.2. Multiple Voltage Constraints From Subcircuits or at Global Nodes

Similar incompatible voltage constraints can be caused by subcircuit definitions, if the subcircuits enforce voltage constraints on one (or more) of their interface nodes. An example netlist fragment is given below. In this example, subcircuits X1 and X2 are trying to enforce incompatible constraints at Node1 in the top-level circuit. This is notionally identical to the first example in the previous subsection. However, these incompatibilities can be harder to find if the subcircuit definitions are located in different library files.

```
X1 node1 0 MySubcircuitA
X2 node1 0 MySubcircuitB
.SUBCKT MYSUBCIRCUITA 1 2
VA 1 0 1
R1A 1 internalNodeA 0.5
R2A internalNodeA 2 0.5
.ENDS
.SUBCKT MYSUBCIRCUITB 3 4
VB 3 0 2
R1B 3 internalNodeB 0.5
R2B internalNodeB 4 0.5
.ENDS
```

Global nodes that have voltage sources applied to them from separate parts of the circuit (e.g., from within subcircuit definitions) can cause yet another version of the DCOP failure modes given in the previous subsection. If these two netlist statements are given in different subcircuit definitions then a Xyce DCOP failure will occur.

```
Vpin1 $G_GlobalNode1 0 1
Vpin2 $G GlobalNode1 0 2
```

Of course, the examples given above can occur in varied combinations.

#### 6.3.3. NODESET and IC Statements in Subcircuits

As previously noted, Xyce does not support .NODESET and .IC statements in subcircuits. This is a common cause of DCOP failure in Xyce when the same netlist converges in PSpice. See sections 2.1.22 and 2.1.14 for more details on how to move those .NODESET and .IC statements to the "top-level" in the Xyce netlist.

#### 6.3.4. No DC Path to Ground for a Current Flow

A Xyce DCOP failure can occur if there is no DC path to ground at a node but a current flow must occur. This can happen because of a typographic error during netlist entry. An simple example is as follows, where the netlist line for R1 has 0 ("oh") rather then 0 ("zero"). It can also happen when all of the current into a subcircuit must flow through capacitors.

```
I1 1 0 1
R1 1 0 1
C1 1 0 2pF
```

## 6.3.5. Inductor Loops

An inductor loop with no DC path to ground will also typically cause a DCOP failure. A simple example is:

```
V1 1 0 1
R1 1 2 1
L1 2 3 2uH
L2 2 3 2uH
R3 3 0 1
```

# 6.3.6. Infinite Slope Transistions

It is possible for a user to specify expressions that could have infinite-slope transitions with B-, E-, F-, G- and H-sources. A common example is IF statements within those source definitions. This can often lead to "timestep too small" errors when Xyce reaches the transition point. In some cases, it can also cause DCOP failures. See Section 2.3.16 and the "Analog Behavioral Modeling" (ABM) chapter of the Xyce Users' Guide [1] for guidance on using the B-source device and ABM expressions. Those recommendations also apply to the E-, F-, G- and H-sources.

# 6.3.7. Simulation Settings

Automatic source stepping was added to Xyce in version 6.3. Xyce also automatically does Gmin stepping when the DCOP calculation fails to converge. In addition, the time integration options normally do not affect the DCOP calculation. So, adjusting the simulation settings for Xyce typically has no effect on the DCOP calculation. However, if both of the automatic homotopy methods mentioned above do not work, and none of the other netlist issues mentioned above exist, then Xyce does have other homotopy methods available. See the Xyce Users' Guide [1] for more details.

# 7. QUICK REFERENCE FOR MICROSOFT WINDOWS USERS

Xyce is supported on Microsoft Windows. However, the primary targets for Xyce are high-performance supercomputers and workstations, which are almost always running a variant of Unix. All of Xyce development is done on Unix platforms. Bearing this in mind, there are occasionally issues with using a Unix application on a Windows platform. Some of these issues are described in the table below.

Table 7-1. Issues for Microsoft Windows.

| Issue  | Comment   |
|--|---|
| File names are case-sensitive                            | Xyce will expect library files, which are referenced in the netlist, to have exactly the same case as the actual filename. If not, Xyce will be unable to find the library file.  |
| Windows endline characters are different from other OS's | The characters that mark the end of a line in Windows are a carriage return followed by a Line Feed (CR+LF). In Unix-like systems (including Linux and OS X), the character is simply a Line Feed (LF). Moving a file between the two systems does not usually cause issues, but users should be aware of the difference in case problems arise.              |
| Xyce is unable to read proprietary file formats.         | Programs such as Microsoft Word by default use file formats that Xyce cannot recognize. It is best not to use such programs to create netlists, unless netlists are saved as *.txt files. If you must use a Microsoft editor, it is better to use Microsoft Notepad. In general, the best solution is to use a Unix-style editor, such as Vi, Gvim, or Emacs. |

#### 8. RAWFILE FORMAT

The rawfile format produced by Xyce closely follows SPICE3 conventions. Differences are noted in section 8.3. Details on the both the ASCII and binary formats are provided here for reference.

## 8.1. ASCII Format

The ASCII file format can be created using the -a flag on the command line. See Chapter 3 for more information.

The ASCII format standard dictates that the file consist of lines or sets of lines introduced by a keyword. The Title and Date lines should be the first in the file, and should occur only once. They are followed by the Plotname, Flags, No. Variables, and No. Points lines for each plot.

Listed next are sets of Variables, and Values lines. Let *numvars* be the number of variables (as specified in the No. Variables line), and *numpts* be the number of points (as shown on the No. Points line). After the Variables keyword there must be *numvars* declarations of outputs, and after the Values keyword, there must be *numpts* lines, each consisting of *numvars* values.

Finally, Xyce also allows for a Version line to be placed after the No. Points line for compatibility with various software programs.

See Table 8-1 for a summary of the above.

Table 8-1. Xyce ASCII rawfile format.

| Issue               | Comment   |
|---------------------|---|
| Title:              | An arbitrary string describing the circuit.   |
| Date:               | A free-format date string.  |
| Plotname:           | A string describing the analysis type.  |
| Flags:              | A string describing the data type (real or complex).  |
| No. Variables:      | The number of variables.  |
| No. Points:         | The number of points.   |
| Version: (optional) | The version of Xyce used to generate this output. By default the version is not output in the header. It can be output with the .options output outputversioninrawfile=true option.   |
| Variables:          | A newline followed by multiple lines, one for each variable, of the form [tab] <index> [tab] <name> [tab] <type>.</type></name></index>   |
| Values:             | A newline followed by multiple lines, for each point and variable, of the form [tab] <value> with an integer index preceding each set of points.  Complex values are output as [tab] <real component="">, <imaginary component=""> .</imaginary></real></value> |

# 8.2. Binary Format

The binary format is similar to the ASCII format, except that strings are null terminated rather than newline terminated. In addition, all the values lines are stored in a binary format. The binary storage of real values as double precision floats is architecture specific.

See Table 8-2 for a summary of the binary table format.

Table 8-2. Xyce binary rawfile format.

| Issue               | Comment  |
|---------------------|--|
| Title:              | An arbitrary string describing the circuit.  |
| Date:               | A free-format date string.   |
| Plotname:           | A string describing the analysis type.   |
| Flags:              | A string describing the data type (real or complex).   |
| No. Variables:      | The number of variables.   |
| No. Points:         | The number of points.  |
| Version: (optional) | The version of Xyce used to generate this output. By default the version is not output in the header. It can be output with the .options output outputversioninrawfile=true option.      |
| Variables:          | A newline followed by multiple lines, one for each variable, of the form [tab] <index> [tab] <name> [tab] <type>.</type></name></index>  |
| Binary:             | Each real data point is stored contiguously in sizeof (double) byte blocks.  Complex values are output as real and imaginary components in a block of size 2*sizeof(double) byte blocks. |

# 8.3. Special Notes

- Complex data points are only output under AC analysis.
- Commands and Options lines are not used.
- Binary header is formatted ASCII.
- Xyce can output an optional Version line in the header.

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# Index

| Xyce                        | PARSER, 116                               |
|-----------------------------|---|
| ABSTOL, 765                 | PCES, 111                                 |
| RELTOL, 765                 | RESTART, 107                              |
| convergence, 765            | SAMPLES, 109                              |
| .AC, 22                     | SENSITIVITY, 112                          |
| .DCVOLT, 27, 46             | TIMEINT, 96                               |
| .EMBEDDEDSAMPLING, 28       | .OP, 92                                   |
| .FFT, 33                    | .PARAM, 117                               |
| .FOUR, 38                   | subcircuit scoping, 118, 157              |
| .FUNC, 40                   | .PCE, 119                                 |
| allowed names, 40           | .PREPROCESS                               |
| subcircuit scoping, 40, 157 | ADDRESISTORS, 124                         |
| .GLOBAL_PARAM, 43           | REMOVEUNUSED, 123                         |
| .GLOBAL, 42                 | REPLACEGROUND, 122                        |
| .нв, 45                     | .PRINT, 23, 25, 45, 91, 125, 158          |
| .IC, 46                     | AC, 23, 133                               |
| .INC, 47                    | DC, 25, 134                               |
| .LIB, 48                    | ES, 140                                   |
| .LIN, 50                    | нв, 45, 135                               |
| .MEASURE FFT, 80            | NOISE, 91, 137                            |
| .MEASURE continuous, 75     | PCE, 140                                  |
| .MEASURE, 52, 56            | TRAN, 137, 158                            |
| .MODEL, 173                 | AC Analysis, 133                          |
| subcircuit scoping, 85, 157 | DC Analysis, 134                          |
| .NODESET, 89                | Device Parameters and Internal Variables, |
| .NOISE, 90                  | 144                                       |
| .OPTIONS, 93, 768, 774      | EMBEDDEDSAMPLING Analysis, 140            |
| DEVICE, 94                  | Harmonic Balance Analysis, 135            |
| DIST, 113                   | Homotopy Analysis, 138                    |
| EMBEDDEDSAMPLES, 110        | Noise Analysis, 137                       |
| FFT, 114                    | Parameter Stepping, 141                   |
| HBINT, 112                  | PCE Analysis, 140                         |
| LINSOL-AC, 106              | Transient Analysis, 137                   |
| LINSOL-HB, 105              | Wildcards, 143                            |
| LINSOL, 103                 | .RESULT, 146                              |
| LOCA, 101                   | .SAMPLING, 147                            |
| MEASURE, 115                | .SAVE, 149                                |
| NONLIN-TRAN, 99             | .SENS, 150                                |
| NONLIN, 99                  | .STEP, 152                                |
| OUTPUT, 106                 | .SUBCKT, 156, 173                         |
|                             |   |

| .TRAN, 106, 158                 | sampling, 28, 147                    |
|---------------------------------|--------------------------------------|
| ABSTOL, 96, 100                 | STEP                                 |
| BPENABLE, 99                    | Decade sweeps, 154                   |
| DATA, 24                        | Linear sweeps, 152                   |
| DC, 25                          | List sweeps, 154                     |
| EXITSTEP, 99                    | Octave sweeps, 154                   |
| EXITTIME, 99                    | step, 152                            |
| MAXSTEP, 100                    | transient, 99, 158, 159              |
| NLNEARCONV, 96                  | Aztec, 102, 106                      |
| NLSMALLUPDATE, 96               |                                      |
| RELTOL, 96, 100                 | behavioral digital                   |
| RESTARTSTEPSCALE, 96            | device instance parameters, 705, 710 |
| 1d pde (level 1)                | device model parameters, 705, 710    |
| device instance parameters, 733 | bias point, 159                      |
| 2d pde (level 2)                | bipolar junction transistor          |
| device instance parameters, 737 | device instance parameters, 245      |
| •                               | device model parameters, 245         |
| AC analysis, 22                 | BJT, 239                             |
| accelerated mass device, 714    | BJT level 230                        |
| Accelerated Mass Devices, 174   | device output variables, 263         |
| adms diodecmc                   | BJT level 234                        |
| device instance parameters, 210 | device output variables, 269         |
| device model parameters, 211    | BJT level 504                        |
| algorithm                       | device output variables, 274         |
| time integration, 774           | BJT level 505                        |
| analog behavioral modeling      | device output variables, 281         |
| POLY, 170                       | bsim-cmg finfet v107.0.0             |
| polynomial expression, 170      | device instance parameters, 595      |
| analysis                        | device model parameters, 595         |
| AC, 22                          | bsim-cmg finfet v108.0.0             |
| control parameters, 93          | device instance parameters, 625      |
| DC, 25, 99                      | device model parameters, 626         |
| Data Sweeps, 26, 154            | bsim-cmg finfet v110.0.0             |
| Decade sweeps, 25               | device instance parameters, 558      |
| Linear sweeps, 25               | device model parameters, 559         |
| List Sweeps, 26                 | bsim-soi 4.5.0                       |
| Octave sweeps, 25               | device instance parameters, 408      |
| EMBEDDEDSAMPLING, 28            | device model parameters, 408         |
| HB, 45                          | bsim-soi 4.6.1                       |
| LHS, 28, 147                    | device instance parameters, 376      |
| MC, 28, 147                     | device model parameters, 377         |
| Monte Carlo, 28, 147            | bsim3                                |
| Noise, 90                       | device instance parameters, 311      |
| op, 92                          | device model parameters, 311         |
| options, 93                     | bsim3 soi                            |
| PCE, 28, 119, 147               | device instance parameters, 325      |
| pce, 119                        | device model parameters, 326         |
| SAMPLING, 28, 147               | bsim4                                |

| device instance parameters, 346             | current controlled voltage source, 173, 236                     |  |  |
|---|---|--|--|
| device model parameters, 347                | delay device, 702   |  |  |
| bsim6                                       | digital devices, 174, 704                                       |  |  |
| device instance parameters, 437             | digital devices, Y type, 709                                    |  |  |
| device model parameters, 438                | diode, 173, 204   |  |  |
| bsource, 237                                | equations, 173  |  |  |
|   | generic switch, 174, 696  |  |  |
| capacitor, 183                              | ideal delay device, 702   |  |  |
| device instance parameters, 184             | independent current source, 173                                 |  |  |
| device model parameters, 184                | independent voltage source, 174, 219, 224                       |  |  |
| checkpoint, 107                             | inductor, 173, 188  |  |  |
| command line, 761                           | JFET, 174, 285  |  |  |
| arguments, 761                              | linear device, 174  |  |  |
| constants (EXP,PI), 40                      | lossless transmission line, 698                                 |  |  |
| controlled switch, 693                      | LTRA, 174   |  |  |
| device model parameters, 695                | ltra, 691   |  |  |
| convergence, 765                            | lumped transmission line, 700                                   |  |  |
| current controlled current source, 233      | memristor, 174  |  |  |
| current controlled voltage source, 236      | MESFET, 174, 289  |  |  |
| current source                              | MOSFET, 174, 291  |  |  |
| current controlled, 233                     | mutual inductor, 173  |  |  |
| independent, 219                            | mutualinductor, 191   |  |  |
| nonlinear dependent, 237                    | nodes, 179  |  |  |
| voltage controlled, 234                     | nonlinear dependent source, 173                                 |  |  |
| -   | package options, 94   |  |  |
| DC analysis, 25, 99                         | PDE Devices, 174, 733   |  |  |
| Data sweeps, 26, 154                        | port device, 174, 230   |  |  |
| Decade sweeps, 25                           | resistor, 174, 198  |  |  |
| Linear sweeps, 25                           | subcircuit, 174   |  |  |
| List sweeps, 26                             | transmission line, 174  |  |  |
| Octave sweeps, 25                           | lossless, 698   |  |  |
| delay element                               | lossy, 691  |  |  |
| device instance parameters, 703             | lumped, 700   |  |  |
| device                                      | voltage controlled current source, 173, 234                     |  |  |
| ABM device                                  | voltage controlled switch, 174                                  |  |  |
| PSpice equivalent, 769                      | voltage controlled voltage source, 173, 231                     |  |  |
| ACC Devices, 174                            | Digital Devices, 174  |  |  |
| accelerated mass devices, 174               | digital devices, 704  |  |  |
| analog, 173                                 | diode, 204  |  |  |
| analog device summary, 173                  | device instance parameters, 206                                 |  |  |
| B source, 173                               | device mistance parameters, 206<br>device model parameters, 206 |  |  |
| bipolar junction transistor (BJT, 174       | -   |  |  |
| BJT, 239                                    | operating temperature, 204 DIODE level 200                      |  |  |
| •   |   |  |  |
| bsource, 237                                | device output variables, 210                                    |  |  |
| capacitor, 173, 183                         | DIODE level 2002  |  |  |
| controlled switch, 693                      | device output variables, 214                                    |  |  |
| current controlled current source, 173, 233 | dist  |  |  |
| current controlled switch, 174              | ontions, 113  |  |  |

| dopingprofiles                       | Lambert-W Function, 95                     |  |  |
|--------------------------------------|--|--|--|
| composite parameters, 740            | Latin Hypercube Sampling analysis, 28, 147 |  |  |
|                                      | layer                                      |  |  |
| ekv3 mosfet                          | composite parameters, 739                  |  |  |
| device instance parameters, 668      | lead currents, 128, 181                    |  |  |
| device model parameters, 668         | legal characters, 180                      |  |  |
| embedded sampling analysis, 28       | level parameter, 86                        |  |  |
| EMBEDDEDSAMPLING analysis, 28        | LHS analysis, 28, 147                      |  |  |
| expressions                          | lin  |  |  |
| operators, 161                       | device model parameters, 697               |  |  |
| SPICE functions, 166                 | linear device, 697                         |  |  |
|                                      | lossless transmission line, 698            |  |  |
| fbh hbtx v2.1                        | lossy transmission line, 691               |  |  |
| device instance parameters, 257      | device model parameters, 691               |  |  |
| device model parameters, 257         | lumped transmission line, 700              |  |  |
| fft, 33                              | device instance parameters, 700            |  |  |
| additional metrics, 36               | device model parameters, 700               |  |  |
| options, 35, 37, 114                 | lutsoi mosfet                              |  |  |
| remeasure, 37                        | device instance parameters, 676            |  |  |
| window functions, 35                 | device model parameters, 676               |  |  |
| generic switch, 696                  | MC analysis, 28, 147                       |  |  |
|                                      | measure                                    |  |  |
| harmonic balance analysis, 45        | err1 measure, 70                           |  |  |
| hicum 10 v1.32                       | err2 measure, 70                           |  |  |
| device instance parameters, 260      | error measure, 70                          |  |  |
| device model parameters, 260         | additional examples, 68                    |  |  |
| hicum v2.4.0                         | expression support, 64                     |  |  |
| device model parameters, 265         | HSPICE compatibility, 73                   |  |  |
|                                      |  |  |  |
| ideal transmission line              | measurement windows 64                     |  |  |
| device instance parameters, 698      | measurement windows, 64                    |  |  |
| illegal characters, 180              | options, 115                               |  |  |
| independent voltage source, 219, 224 | re-measure, 65                             |  |  |
| inductor, 188                        | supported operators for AC measures, 71    |  |  |
| device instance parameters, 190      | suppressing measure output, 69             |  |  |
| device model parameters, 190         | unsupported types, 72                      |  |  |
| initial condition, 27, 46, 89        | measure continuous                         |  |  |
| DCVOLT, 27, 46                       | HSPICE compatibility, 79                   |  |  |
| IC, 46                               | measurement output, 77                     |  |  |
| NODESET, 89                          | rise, fall and cross qualifiers, 78        |  |  |
|                                      | measure fft                                |  |  |
| JFET, 285                            | additional examples, 83                    |  |  |
| jfet                                 | re-measure, 37, 83                         |  |  |
| device instance parameters, 286, 287 | memristor, 726                             |  |  |
| device model parameters, 286, 287    | memristorpem                               |  |  |
| juncap200 diode                      | device instance parameters, 730            |  |  |
| device instance parameters, 207      | device model parameters, 731               |  |  |
| device model parameters, 207         | memristorteam                              |  |  |

| device instance parameters, 307                      |
|--|
| device model parameters, 307                         |
| mosfet level 6                                       |
| device instance parameters, 309                      |
| device model parameters, 309                         |
| MOSFET level 70                                      |
| device output variables, 406                         |
| MOSFET level 70450                                   |
| device output variables, 435                         |
| MOSFET level 77                                      |
| device output variables, 464                         |
| mutualinductor, 191                                  |
| B-H loop calculations, 196                           |
| Converting nonlinear to linear mutual                |
| indcutors, 196                                       |
| mutual inductor equations, 194                       |
| mvs etsoi 2.0.0                                      |
| device model parameters, 659                         |
| mvs hemt 2.0.0                                       |
| device model parameters, 659                         |
| mvsg-hv hemt model                                   |
| device instance parameters, 661                      |
| device model parameters, 661                         |
|  |
| netlist  |
| commands, 22   |
| comment, 160   |
| expression operators, 161                            |
| functions, 166                                       |
| in-line comment, 160 line continuation, 160          |
| ·  |
| model definition, 173                                |
| nodes, 179<br>reference, 21                          |
| subcircuit, 173                                      |
| node   |
|  |
| composite parameters, 739, 740<br>Noise analysis, 90 |
| nonlinear mutual inductor                            |
|  |
| device model parameters, 192                         |
| Operating Point, 25                                  |
| operating point analysis, 92                         |
| output   |
| control, 52, 75, 80                                  |
| save, 149  |
| ,  |
| parallel   |
| computing, 19  |
|  |

| parameters                                       | device model parameters, 200, 202         |  |  |
|--|---|--|--|
| convergence, 765                                 | restart, 107                              |  |  |
| parser   | file, 108                                 |  |  |
| options, 116                                     | two-level, 109                            |  |  |
| PCE analysis, 28, 119, 147                       | results                                   |  |  |
| PDE Devices, 174, 733                            | fft, 33                                   |  |  |
| 1D instance parameters, 733, 737                 | measure, 56                               |  |  |
| model parameters, 733                            | measure continuous, 76                    |  |  |
| Physical Models, 743                             | measure fft, 80                           |  |  |
| time integration parameters, 99                  | output control, 52, 75, 80                |  |  |
| POLY, 170  | output options, 106                       |  |  |
| port device, 230                                 | print, 23, 25, 45, 91, 125, 158           |  |  |
| power calculations, 181                          | sens, 150                                 |  |  |
| power grid, 715                                  | *   |  |  |
| power mosfet                                     | SAMPLING analysis, 147                    |  |  |
| device instance parameters, 372                  | sampling analysis, 147                    |  |  |
| device model parameters, 372                     | Sandia National Laboratories, 19          |  |  |
| powergridbranch                                  | save operating point conditions, 149      |  |  |
| device instance parameters, 716                  | sensitivity, 150                          |  |  |
| powergridbusshunt                                | solvers                                   |  |  |
| device instance parameters, 718                  | continuation                              |  |  |
| powergridgenbus                                  | options, 101                              |  |  |
| device instance parameters, 722                  | control parameters, 93                    |  |  |
| powergridtransformer                             | embeddedsampling                          |  |  |
| device instance parameters, 720                  | options, 110                              |  |  |
| psp102va legacy mosfet 102.5                     | hb  |  |  |
| device instance parameters, 467                  | options, 112                              |  |  |
| device model parameters, 468                     | homotopy                                  |  |  |
| psp103va mosfet                                  | options, 101                              |  |  |
|  | linear                                    |  |  |
| device instance parameters, 485                  | Aztec, 102, 106                           |  |  |
| device model parameters, 486                     | iterative (preconditioned Krylov methods) |  |  |
| psp103va mosfet with self-heating                | 102                                       |  |  |
| device instance parameters, 521                  | options, 102, 103, 105                    |  |  |
| device model parameters, 522                     | sparse-direct, 102                        |  |  |
| PSpice, 767, 773, 775                            | Trilinos, 102, 106                        |  |  |
| E device, 769                                    | nonlinear                                 |  |  |
| F device, 769                                    | options, 99, 766                          |  |  |
| G device, 769                                    | nonlinear-transient                       |  |  |
| H device, 769                                    | options, 101                              |  |  |
| Probe, 126                                       | PCE                                       |  |  |
| rawfile, 781                                     | options, 111                              |  |  |
| ASCII, 781                                       | pce                                       |  |  |
|  | *   |  |  |
| binary, 782                                      | options, 111 sampling                     |  |  |
| region  composite parameters 741                 | options, 109                              |  |  |
| composite parameters, 741                        | -   |  |  |
| resistor, 198 device instance parameters 200 201 | sensitivity options 112                   |  |  |
| GOVICA HISIAHAA DALAHIELEIN ZUU ZUU              | OUROUS 117.                               |  |  |

```
sensitivty
      options, 112
    time integration
      options, 765
    time integration, 159, 774
      options, 96, 99
STEP analysis
    Decade sweeps, 154
    Linear sweeps, 152
    List sweeps, 154
    Octave sweeps, 154
step parametric analysis, 152
subcircuit, 156, 732
    designation, 157
    name, 156
    nesting, 157
    node zero, 157
    scoping, 157
TCAD Devices, 733
    Physical Models, 743
    time integration parameters, 99
time step
    size, 159, 774
transient analysis, 99, 158
    error tolerances, 765
Trilinos, 102, 106
Unix, 20
Users of PSpice, 767
Users of Xyce on Microsoft Windows, 780
VBIC (temperature considerations), 243
vbic 1.3 3t
    device instance parameters, 248
    device model parameters, 248
vbic 1.3 4t
    device instance parameters, 253
    device model parameters, 253
voltage controlled current source, 234
voltage controlled voltage source, 231
Voltage Nodes, 179
voltage source
    current controlled, 236
    independent, 224
    nonlinear dependent, 237
    voltage controlled, 231
```

Y type digital devices, 709

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